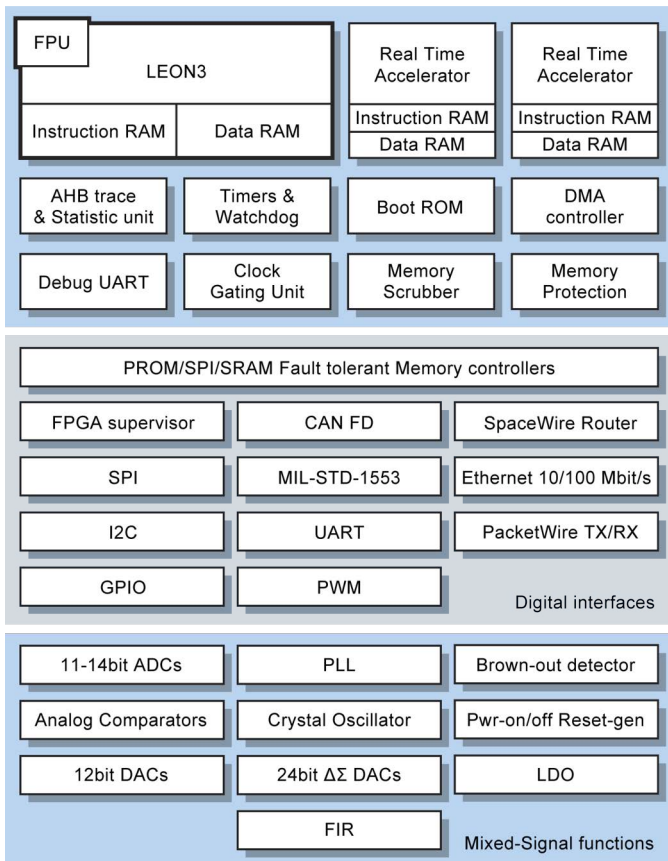


# LEON3FT Microcontroller

## GR716B

### Features

- Fault-tolerant SPARC V8 processor with 31 register windows, 128KiB EDAC protected tightly coupled memory and support for compressed instruction set
- Double precision IEEE-754 floating point unit
- Memory protection units
- Non-intrusive advanced on-chip debug support unit
- External EDAC protected 8-bit PROM/SRAM, SPI memory protected by EDAC and dual memory redundancy
- Hardware FPGA programming and scrubbing
- Real-Time Accelerators with 64KiB EDAC protected tightly coupled memory, programmable DMA
- SpaceWire router with 2 external ports and time distribution
- MIL-STD-1553B interface
- CAN FD interface with CANOpen support
- PacketWire with CRC acceleration support
- Programmable PWM interface
- Programmable Delta-Sigma modulator DAC
- SPI with SPI-for-Space protocol support
- Four channel 12-bit DAC, four 11-14-bit ADC and twenty fast analogue comparators
- 10/100 Ethernet, UARTs, SPI, I<sup>2</sup>C, GPIO, Timers with Watchdog, Interrupt controller, UART debug, etc
- Crystal oscillator, with external XTAL
- Precision reference 1.9 V output



### Description

The GR716B device is a fault-tolerant LEON3FT SPARC V8 processor with various communication interfaces and on-chip ADC, DAC, Power-on-Reset, Oscillator, Brown-out detection, LVDS transceivers with extended common-mode, cold-spare and fail-safe, regulators to support single 3.3V supply, ideally suited for space and other high-rel applications.

### Specification

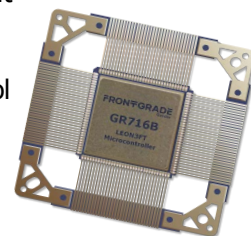
- System frequency up to 100 MHz
- SpaceWire links up to 200 Mbps
- CQFP132 hermetically sealed ceramic package
- Total Ionizing Dose (TID): 100 krad(Si) full performance, functionality tested up to 300 krad(Si)
- Single-Event Latch-up Immunity (SEL) to  $LET_{TH} > 118 \text{ MeV-cm}^2/\text{mg}$
- Single-Event Upset (SEU)  $< 1E-5$  event/device/day (TBC) in space environment
- Support for single 3.3V supply

### Applications

The GR716B microcontroller is an advanced microcontroller, targeting high reliability space and aeronautics applications.

Support for many different standard interfaces makes the GR716B microcontroller ideal for supervision, monitoring and control in a satellite, such as:

- motor control
- program and scrubber support of FPGA
- switching power converters
- power system monitoring and latch-up detection
- magnetorquer control
- remote terminal control unit
- propulsion system control
- sensor bus control
- robotics applications control
- instrument control unit
- antenna pointing control
- nanosatellite controller



### Availability

The GR716B microcontroller is currently under validation and there is no guarantee that functionality or performance will not change.

# LEON3FT Microcontroller

1	Introduction.....	10
1.1	Scope .....	10
1.2	Data sheet limitations .....	10
1.3	Updates and feedback.....	10
1.4	Software support.....	10
1.5	Development board .....	10
1.6	Reference documents .....	11
1.7	Document revision history .....	12
1.8	Acronyms .....	13
1.9	Definitions .....	14
1.10	Register descriptions .....	15
2	Architecture.....	16
2.1	Key features.....	17
2.2	Digital Architecture Overview .....	20
2.3	Analog Architecture Overview.....	34
2.4	Signal Overview .....	41
2.5	I/O switch matrix overview .....	41
2.6	I/O switch for APWM_DAC output signals.....	44
2.7	I/O switch default configurations for bootstraps.....	45
2.8	I/O switch matrix options, considerations and limitations .....	49
2.9	Cores.....	50
2.10	Memory map .....	51
2.11	Atomic access.....	57
2.12	Interrupts .....	58
3	Signals.....	60
3.1	Bootstrap signals .....	60
3.2	Configuration for flight .....	69
4	Clocking.....	70
4.1	PLL Configuration and Status .....	72
4.2	Clock Source and divisor .....	72
4.3	System clock.....	73
4.4	SpaceWire clock.....	73
4.5	MIL-STD-1553B clock .....	73
4.6	PacketWire RX Clock .....	73
4.7	ADC Clock.....	74
4.8	DAC Clock .....	74
4.9	Clock gating unit .....	74
4.10	Debug AHB bus clocking.....	74
4.11	PLL Lock and clock output .....	74
5	Reset.....	75
5.1	IO Reset.....	75
6	Technical notes.....	77
6.1	GRLIB AMBA plug&play scanning .....	77
6.2	Software portability .....	77
7	System Startup Status and General Configuration.....	78
7.1	Configuration Registers.....	78
7.2	Bootstrap information register.....	84
7.3	Special Configuration Registers .....	85

# LEON3FT Microcontroller

8	Reset Generation and Brownout Detection.....	92
	8.1 Overview .....	92
	8.2 Operation .....	92
	8.3 Registers .....	93
9	Crystal Oscillator (XO).....	97
	9.1 Overview .....	97
	9.2 Operation .....	97
10	PLL.....	102
	10.1 Overview .....	102
	10.2 Operation .....	102
	10.3 Registers .....	103
11	Voltage and Current References.....	110
	11.1 Overview .....	110
	11.2 Operation .....	110
12	ADC, Pre-Amplifier and Analog MUX .....	111
	12.1 Overview .....	111
	12.2 Operation .....	112
	12.3 Registers .....	122
13	LDO .....	126
	13.1 Overview .....	126
	13.2 Operation .....	126
14	Temperature Sensor.....	128
	14.1 Overview .....	128
	14.2 Operation .....	128
15	DAC .....	129
	15.1 Overview .....	129
	15.2 Operation .....	130
	15.3 Registers .....	131
16	Fast Analog Comparator (ACOMP) and filter (FIR).....	136
	16.1 Overview (TBD).....	136
	16.2 Operation .....	138
	16.3 Registers .....	138
17	LEON3/FT - High-performance SPARC V8 32-bit Processor .....	146
	17.1 Overview .....	146
	17.2 LEON3 integer unit .....	147
	17.3 Local instruction and data RAM .....	155
	17.4 GRFPU-Lite floating-point unit .....	155
	17.5 AMBA interface .....	156
	17.6 Configuration registers .....	157
	17.7 Software considerations .....	163
18	IEEE-754 Floating-Point Unit .....	164
	18.1 Overview .....	164
	18.2 Functional Description .....	164
19	UART Serial Interface .....	167
	19.1 Overview .....	168
	19.2 Operation .....	168

# LEON3FT Microcontroller

19.3	Baud-rate generation .....	169
19.4	Loop back mode .....	170
19.5	FIFO debug mode.....	170
19.6	Interrupt generation .....	170
19.7	Registers .....	171
<b>20</b>	<b>Hardware Debug Support Unit .....</b>	<b>174</b>
20.1	Overview .....	174
20.2	Operation.....	174
20.3	AHB trace buffer .....	175
20.4	Instruction trace buffer .....	177
20.5	Using the DSU trace buffer .....	178
20.6	DSU memory map.....	178
20.7	DSU registers .....	179
<b>21</b>	<b>On-chip Dual-port Memory with EDAC Protection.....</b>	<b>185</b>
21.1	Overview .....	185
21.2	Local Memory memory map and register .....	188
<b>22</b>	<b>Fault Tolerant PROM/SRAM Memory Interface .....</b>	<b>192</b>
22.1	Overview .....	192
22.2	PROM access .....	193
22.3	SRAM access .....	195
22.4	Memory EDAC .....	195
22.5	Bus Ready signalling.....	196
22.6	Access errors .....	198
22.7	Registers .....	199
<b>23</b>	<b>Fault Tolerant NVRAM Memory Interface .....</b>	<b>203</b>
<b>24</b>	<b>MIL-STD-1553B / AS15531 Interface .....</b>	<b>204</b>
24.1	Overview .....	204
24.2	Electrical interface.....	205
24.3	Operation.....	205
24.4	Bus Controller Operation .....	207
24.5	Remote Terminal Operation .....	212
24.6	Bus Monitor Operation.....	216
24.7	Registers .....	217
<b>25</b>	<b>Ethernet Media Access Controller (MAC) .....</b>	<b>229</b>
25.1	Overview .....	229
25.2	Operation .....	230
25.3	Tx DMA interface .....	231
25.4	Rx DMA interface .....	232
25.5	MDIO Interface .....	234
25.6	Media Independent Interfaces .....	234
25.7	Registers .....	235
<b>26</b>	<b>CAN Flexible Data-Rate Controller with CANOpen support .....</b>	<b>239</b>
26.1	Overview .....	239
26.2	CAN Interface .....	241
26.3	Protocol compliance .....	241
26.4	Status and monitoring.....	241
26.5	CAN and CAN-FD frames .....	242

# LEON3FT Microcontroller

26.6	Operational modes.....	244
26.7	Standard Mode - Transmission.....	245
26.8	Standard Mode - Reception.....	248
26.9	CANOpen mode.....	251
26.10	CANFD reset and enable.....	255
26.11	Registers.....	255
27	<b>Clock gating unit (Primary) .....</b>	<b>271</b>
27.1	Overview.....	271
27.2	Operation.....	271
27.3	Registers.....	272
28	<b>Clock gating unit (Secondary) .....</b>	<b>275</b>
28.1	Overview.....	275
28.2	Operation.....	275
28.3	Registers.....	276
29	<b>Direct Memory Access Controller .....</b>	<b>279</b>
29.1	Overview.....	279
29.2	Operation.....	280
29.3	Configuration.....	285
29.4	Interrupts.....	291
29.5	Status and Errors.....	291
29.6	GRDMAC2 Use case Example.....	292
29.7	Registers.....	295
30	<b>General Purpose I/O Port.....</b>	<b>301</b>
30.1	Overview.....	302
30.2	Operation.....	302
30.3	Pulse command (TBD).....	302
30.4	Registers.....	302
31	<b>PacketWire Receiver.....</b>	<b>308</b>
31.1	Overview.....	308
31.2	PacketWire interface.....	308
31.3	Operation.....	309
31.4	Operation.....	309
31.5	Registers.....	311
32	<b>PacketWire Transmitter.....</b>	<b>314</b>
32.1	Overview.....	314
32.2	PacketWire interface.....	314
32.3	Operation.....	315
32.4	Registers.....	316
33	<b>SpaceWire router.....</b>	<b>319</b>
33.1	Overview.....	319
33.2	Operation.....	320
33.3	SpaceWire ports.....	331
33.4	AMBA ports.....	333
33.5	Configuration port.....	356
33.6	Registers.....	361
34	<b>SpaceWire - Time Distribution Protocol.....</b>	<b>384</b>
34.1	Overview.....	384

# LEON3FT Microcontroller

34.2	Protocol .....	384
34.3	Functionality.....	384
34.4	Registers .....	392
35	General Purpose Timer Unit with Watchdog .....	403
35.1	Overview .....	403
35.2	Operation .....	403
35.3	Registers .....	405
36	General Purpose Timer Unit (Secondary).....	409
36.1	Overview .....	409
36.2	Operation .....	409
36.3	Registers .....	410
37	I2C to AHB bridge .....	414
37.1	Overview .....	414
37.2	Operation .....	415
37.3	Registers .....	419
38	I2C master .....	422
38.1	Overview .....	422
38.2	Operation .....	423
38.3	Registers .....	426
39	I2C slave .....	429
39.1	Overview .....	429
39.2	Operation .....	430
39.3	Registers .....	432
40	Interrupt Controller .....	436
40.1	Overview .....	436
40.2	Operation .....	437
40.3	Registers .....	441
41	LEON3 Statistics Unit .....	453
41.1	Overview .....	453
41.2	Using the LEON3 statistics unit.....	455
41.3	Registers .....	455
42	Memory Scrubber and Status Register .....	458
42.1	Overview .....	459
42.2	Operation .....	459
42.3	Registers .....	461
43	SPI to AHB bridge .....	466
43.1	Overview .....	466
43.2	Transmission protocol .....	467
43.3	System clock requirements and sampling .....	468
43.4	SPI instructions.....	468
43.5	Registers .....	470
44	SPI Controller .....	472
44.1	Overview .....	472
44.2	Operation .....	473
44.3	Registers .....	476
45	SPI for Space Slave Controller .....	483

# LEON3FT Microcontroller

45.1	Overview .....	483
45.2	Implementation of SPI protocols.....	484
45.3	Transmission.....	484
45.4	Operation .....	485
45.5	SPI 2 Protocol Handler.....	485
45.6	Message Header - Command Token.....	486
45.7	Redundancy .....	492
45.8	Registers .....	493
46	SPI Memory Controller.....	498
46.1	Overview .....	499
46.2	Operation .....	499
46.3	Registers .....	502
47	AMBA Protection Unit .....	506
47.1	Overview .....	506
47.2	Operation .....	507
47.3	Registers .....	507
47.4	Example of configure and use the Memory protection .....	523
48	Serial Debug and Remote Access Interface .....	525
48.1	Overview .....	526
48.2	Operation .....	527
48.3	Registers .....	528
49	AHB Status Registers .....	530
49.1	Overview .....	530
49.2	Operation .....	530
49.3	Registers .....	531
50	Trace buffer .....	533
50.1	Overview .....	533
50.2	Operation .....	534
50.3	Using the AHB trace buffer .....	535
50.4	Registers .....	536
51	Boot ROM.....	539
51.1	Overview .....	539
51.2	ROM Architecture .....	540
51.3	Loader description .....	545
51.4	Standby description .....	546
51.5	State at handover to application software.....	546
51.6	Boot source requirements (TBD) .....	548
51.7	Protection schemes .....	548
52	Real-Time Accelerator (RTA) .....	551
52.1	Overview .....	551
52.2	Operation (TBD) .....	551
52.3	RTA Status and mailbox Register.....	552
53	Analog Applications Pulse Width Modulation (APWM) .....	555
53.1	Overview of APWM unit .....	556
53.2	APWM_AB description .....	557
53.3	APWM_A description .....	561
53.4	APWM_CF description.....	563

# LEON3FT Microcontroller

53.5	APWM_G description.....	565
53.6	Timers and Synchronization.....	569
53.7	Alarm Matrix and Shutdown.....	569
53.8	Registers.....	570
53.9	System Timers.....	572
53.10	APWM REGSYNC.....	573
53.11	Protection shutdown.....	574
53.12	External Sync Control.....	577
53.13	Clock Error Detect.....	578
53.14	APWM A.....	579
53.15	APWM AB.....	580
53.16	APWM CF.....	581
53.17	APWM G.....	583
53.18	APWM G*.....	584
53.19	Application Notes for APWM Controllers.....	585
<b>54</b>	<b>Digital Modulator for Analog Precision DAC Outputs (APWM_DAC).....</b>	<b>599</b>
54.1	Overview.....	599
54.2	Operation.....	600
54.3	Application Examples of PCB Filters.....	601
54.4	Registers.....	603
<b>55</b>	<b>FPGA Scrubber Controller.....</b>	<b>605</b>
55.1	Overview.....	605
55.2	Soft error mitigation.....	606
55.3	Operation.....	607
55.4	Mask data information.....	613
55.5	FPGA frame information.....	614
55.6	Golden memory.....	614
55.7	SelectMap configuration interface.....	616
55.8	Soft-errors affecting the FPGA configuration interface.....	617
55.9	Interrupts.....	617
55.10	GRSCRUB error codes.....	617
55.11	Enabling and disabling the GRSCRUB.....	619
55.12	Bus master interface.....	620
55.13	Registers.....	620
55.14	Implementation.....	627
<b>56</b>	<b>LVDS IO.....</b>	<b>630</b>
56.1	Overview.....	630
56.2	Operation.....	630
56.3	Registers.....	630
<b>57</b>	<b>Electrical description.....</b>	<b>633</b>
57.1	Absolute maximum ratings.....	633
57.2	Recommended operating conditions.....	635
57.3	Power supply characteristics.....	637
57.4	Simplified schematics for IO buffers.....	638
57.5	Input voltages, leakage currents and capacitances.....	641
57.6	Output voltages, leakage currents and capacitances.....	644
57.7	DAC Electrical Characteristics.....	646
57.8	ADC Electrical Characteristics.....	647
57.9	Analog Comparator Electrical Characteristics.....	650



# LEON3FT Microcontroller

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57.10	Reference Voltages and Currents Electrical Characteristics .....	651
57.11	Reset and Brownout Detector Electrical Characteristics .....	653
57.12	Core Supply LDO Electrical Characteristics.....	656
57.13	AC characteristics.....	657
58	<b>Mechanical description .....</b>	<b>669</b>
58.1	Component and package .....	669
58.2	Pin assignment.....	669
58.3	Mechanical package drawings.....	674
59	<b>Ordering information .....</b>	<b>676</b>
59.1	Silicon and mask information.....	677
60	<b>Errata.....</b>	<b>678</b>
60.1	Overview .....	678
60.2	Errata description .....	678

# LEON3FT Microcontroller

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## 1 Introduction

### 1.1 Scope

This document is the advanced data sheet and user's manual for the GR716B LEON3FT microcontroller. The GR716B microcontroller has been developed in an activity initiated by the European Space Agency.

### 1.2 Data sheet limitations

Note that this document is an advanced data sheet:

- Advanced data sheet - Product in development
- Preliminary data sheet - Shipping prototype
- Data sheet - Shipping space-grade product

### 1.3 Updates and feedback

Updates are available at <https://www.gaisler.com/gr716b>

Feedback: [support@gaisler.com](mailto:support@gaisler.com)

For commercial questions please contact [sales@gaisler.com](mailto:sales@gaisler.com)

### 1.4 Software support

The GR716B LEON3FT microcontroller design is supported by standard toolchains provided by Frontgrade Gaisler. Toolchains can be downloaded from <https://www.gaisler.com>.

### 1.5 Development board

Planned development boards:

- GR716B Software Development Boards - TBC
- GR716B Hardware Development Board - Daughter - TBC
- GR716B DCDC Evaluation Board - TBC
- GR716B Motor Control Evaluation Board - TBC
- GR716B Magnetorquer Evaluation Board - TBC

The GR716B Hardware development board are compatible (TBC) and can be used with the GR-CPCI-GR716-DEV Interface board available on <https://www.gaisler.com/gr716-boards>.

# LEON3FT Microcontroller

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## 1.6 Reference documents

[AMBA]	AMBA Specification, Rev 2.0, ARM Limited
[CCSDS]	Time Code Formats, CCSDS 301.0-B-4, Blue Book, Issue 4, November 2010, <a href="http://www.CCSDS.org">http://www.CCSDS.org</a>
[FPGA]	GR716B Application note for FPGA scrubbing, TN-7, Issue 0.1
[GRLIB]	GRLIB IP Library User's Manual, Frontgrade Gaisler, <a href="http://www.gaisler.com">www.gaisler.com</a>
[GRIP]	GRLIB IP Core User's Manual, Frontgrade Gaisler, <a href="http://www.gaisler.com">www.gaisler.com</a>
[GRMON3]	GRMON3 User's Manual, Frontgrade Gaisler
[LEON-REX]	LEON-REX Instruction Set Extension, Frontgrade Gaisler
[RMAP]	Space engineering: SpaceWire - Remote memory access protocol, ECSS-E-ST-50-52C, February 2010
[SPARC]	The SPARC Architecture Manual, Version 8, SPARC International Inc.
[SPW]	Space engineering: SpaceWire - Links, nodes, routers and networks, ECSS-E-ST-50-12C
[SPWCUC]	High Accuracy Time Synchronization over SpaceWire Networks, SPWCUC-REP-0003, Version 1.1, September 2012
[SPWTDP]	Spreadsheet to configure the GRSPWTDP timer, Issue 1, <a href="https://gaisler.com/doc/spwtdp/grspwtdp_settings_issue1.ods">https://gaisler.com/doc/spwtdp/grspwtdp_settings_issue1.ods</a>
[V8E]	SPARC-V8 Supplement, SPARC-V8 Embedded (V8E) Architecture Specification, SPARC-V8E, Version 1.0, SPARC International Inc.

# LEON3FT Microcontroller

## 1.7 Document revision history

Change record information is provided in table 1.

Table 1. Change record

Version	Date	Sections	Note
0.0	July 2020		First internal release
0.1	November 2020		Update after PDR review
0.2	March 2022		Release for DDR review
0.3	November 2022		Release for CDR review
0.4	November 2022	<b>figure 7</b>	Improved figure for motor control
		<b>figure 117</b>	Corrected APWG block input/states
		54.1.4	Corrected number of inputs/states
		55.4.4	Updated APWM-DAC Chapter
		Table 761	Corrected reference current
		Table 760	Added Table for ADC 13/14 Bit mode
		2.2.10	Added text for FPGA Configuration and Supervision
0.5	December 2022	34	First public release
0.6	September 2023	All	Frontgrade format
		Section 12.2.2	Added Minimum track time required for ADCs
		Section 58	Updated Section 58.1 AMR, 58.2 ROC and 58.9 Reference Voltages and Currents Electrical Characteristics
		Section 2.12	Updated Memory map
0.7	April 2024		Major updates

# LEON3FT Microcontroller

## 1.8 Acronyms

Table 2. Acronyms

Acronym	Comment
AHB	Advanced High-performance bus, part of [AMBA]
AMBA	Advanced Microcontroller Bus Architecture
APB	Advanced Peripheral Bus, part of [AMBA]
BCH	Bose–Chaudhuri–Hocquenghem, class of error-correcting codes
CAN	Controller Area Network, bus standard
CPU	Central Processing Unit, used to refer to one LEON3FT processor core.
DMA	Direct Memory Access
DSU	Debug Support Unit
EDAC	Error Detection and Correction
FIFO	First-In-First-Out, refers to buffer type
FPU	Floating Point Unit
Gb	Gigabit, $10^9$ bits
GB	Gigabyte, $10^9$ bytes
GiB	Gibibyte, gigabinary byte, $2^{30}$ bytes, unit defined in IEEE 1541-200
I/O	Input/Output
ISR	Interrupt Service Routine
JTAG	Joint Test Action Group (developer of IEEE Standard 1149.1-1990)
kB	Kilobyte, $10^3$ bytes
KiB	Kibibyte, $2^{10}$ bytes, unit defined in IEEE 1541-2002
Mb, Mbit	Megabit, $10^6$ bits
MB, Mbyte	Megabyte, $10^6$ bytes
MiB	Mebibyte, $2^{20}$ bytes, unit defined in IEEE 1541-2002
MVT	Multi Vector Trapping
PROM	Programmable Read Only Memory
RAM	Random Access Memory
SEE	Single Event Effects
SEL/SEU/ SET	Single Event Latchup/Upset/Transient
SPARC	Scalable Processor ARChitecture
SVT	Single Vector Trapping
SW	Software
UART	Universal Asynchronous Receiver/Transmitter

# LEON3FT Microcontroller

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## 1.9 Definitions

This section and the following subsections define the typographic and naming conventions used throughout this document.

### 1.9.1 Bit numbering

The following conventions are used for bit numbering:

- The most significant bit (MSb) of a data type has the leftmost position
- The least significant bit of a data type has the rightmost position
- Unless otherwise indicated, the MSb of a data type has the highest bit number and the LSb the lowest bit number

### 1.9.2 Radix

The following conventions is used for writing numbers:

- Binary numbers are indicated by the prefix "0b", e.g. 0b1010.
- Hexadecimal numbers are indicated by the prefix "0x", e.g. 0xF00F
- Unless a radix is explicitly declared, the number should be considered a decimal.

### 1.9.3 Data types

Byte (BYTE)	8 bits of data
Halfword (HWORD)	16 bits of data
Word (WORD)	32 bits of data

# LEON3FT Microcontroller

## 1.10 Register descriptions

An example register, showing the register layout used throughout this document, can be seen in table 3. The values used for the reset value fields are described in table 4, and the values used for the field type fields are described in table 5. Fields that are named RESERVED, RES, or R are read-only fields. These fields can be written with zero or with the value read from the same register field.

Table 3. <Address> - <Register acronym> - <Register name>

31	24 23	16 15	8 7	0
EF3	EF2	EF1	EF0	
<Reset value for EF3>	<Reset value for EF2>	<Reset value for EF1>	<Reset value for EF0>	
<Field type for EF3>	<Field type for EF2>	<Field type for EF1>	<Field type for EF0>	

31: 24	Example field 3 (EF3) - <Field description>
23: 16	Example field 2 (EF2) - <Field description>
15: 8	Example field 1 (EF1) - <Field description>
7: 0	Example field 0 (EF0) - <Field description>

Table 4. Reset value definitions

Value	Description
0	Reset value 0.
1	Reset value 1. Used for single-bit fields.
0xNN	Hexadecimal representation of reset value. Used for multi-bit fields.
0bNN	Binary representation of reset value. Used for multi-bit fields.
NR	Field not reset
*	Special reset condition, described in textual description of the field. Used for example when reset value is taken from a pin.
-	Don't care / Not applicable

Table 5. Field type definitions

Value	Description
r	Read-only. Writes have no effect.
w	Write-only. Used for a writable field in a register where the field's read-value has no meaning.
rw	Readable and writable.
rw*	Readable and writable. Special condition for write, described in textual description of field.
wc	Write-clear. Readable, and cleared when written with a 1
cas	Readable, and writable through compare-and-swap. Only applies to SpaceWire Plug-and-Play registers.

# LEON3FT Microcontroller

## 2 Architecture

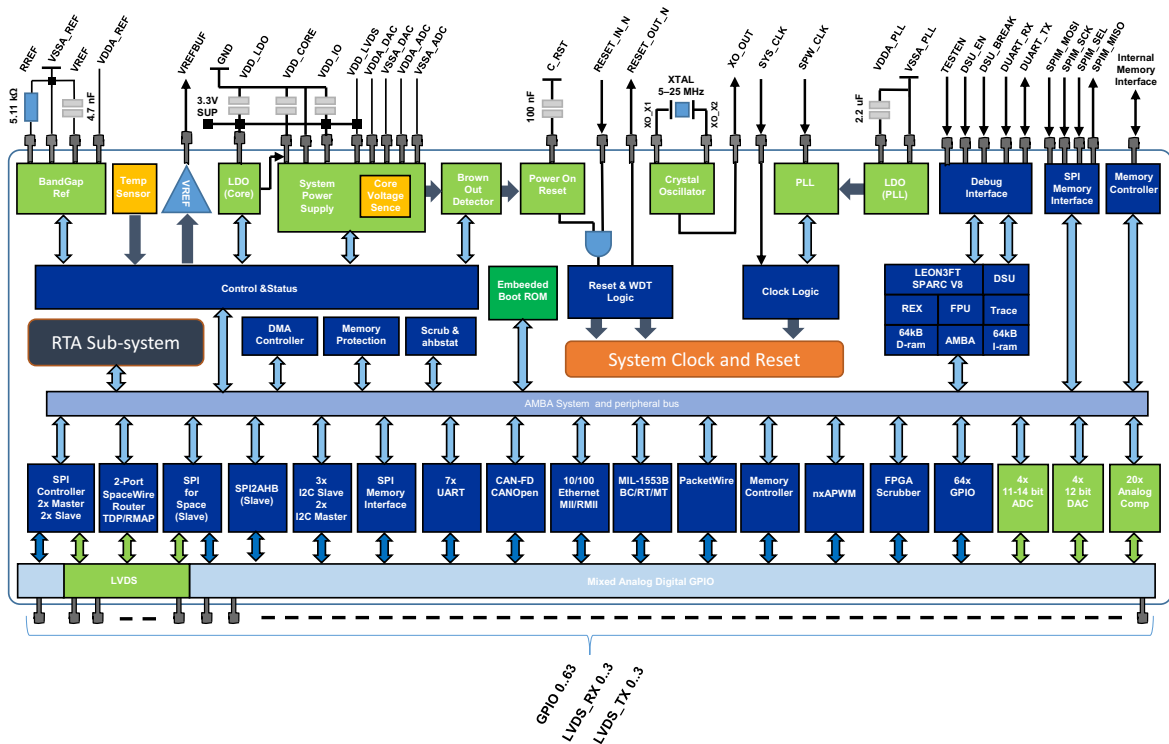


Figure 1. GR716B 132-pin block diagram

The microcontroller is a single core LEON3FT SPARC V8 processor, with advanced interface protocols, that has been optimized for real-time systems and deterministic software execution. Features such as SPARC V8E Alternate Window Pointer, interrupt zero jitter latency, SPARC V8E multiply step instructions and the possibility to run software (including interrupt handlers) from local RAM are supported to increase the determinism and responsiveness in the system. The LEON-REX instruction set extension is also supported by the microcontroller and is further described in [LEON-REX].

The architecture has multiple instances of the AMBA Advanced High-speed Bus (AHB), to which the LEON3FT processor and other high-bandwidth units are connected. Low bandwidth peripherals/functions are connected to the AMBA Advanced Peripheral Bus (APB) which is accessed through an AHB to APB bridge. The use of multiple processor buses also enables non-intrusive debugging and the possibility to have direct access to on-board memory without interrupting or involving the LEON3FT processor.

64 external CMOS pins, 5 LVDS transmitters and 4 LVDS receivers are configurable from software via configuration registers. Pre-defined pin configurations are defined in the boot software and can be enabled by using pull-up/pull-down resistors on external pins during reset. Pre-defined configuration of external pins are useful in cases when the microcontroller should boot from external memories or remote controlled via SpaceWire, CAN-FD, UART and SPI after reset. The program controlling the microcontroller needs to set appropriate direction and functionality on all pins after reset depending on the environment that the microcontroller is used in. On-chip LVDS transceivers with support for extended common-mode, cold-spare and fail-safe for SpaceWire and SPI for Space and dedicated pins for external SPI boot ROM boot are available and can optionally be used.

The microcontroller has a high level of integrated analog functions. Analog functions integrated on-chip include analog to digital converters (ADC), digital to analog converters (DAC), fast analog comparators (ACOMP), precision voltage reference (VREF), crystal oscillator (XO), phase-locked loop oscillator (PLL), brownout detection (BO), power-on and reset functionality, and supply voltage regulators (LDO) to support single 3.3V supply.



# LEON3FT Microcontroller

## 2.1 Key features

- Core
  - Fault-tolerant SPARC V8 processor with 31 register windows and support for LEON-REX.
  - Double precision IEEE-754 floating point unit.
  - Memory protection units with eight zones and individual access control of APB peripherals for memory protection.
  - Advanced on-chip debug support unit with trace buffers and statistic unit for software profiling.
  - Single cycle instructions execution and data fetch from tightly coupled memory.
  - Deterministic instruction execution time and interrupt latency.
  - Fast context switching (Partial write %PSR, AWP, Register file partitioning, interrupt mapping, MVT).
  - Single Vector Trap support.
  - Interrupt zero jitter delay.
- Memories
  - 128KiB EDAC protected tightly coupled memory with single cycle access from processor.
  - Embedded ROM with boot loader for initializing and remote access.
  - Dedicated SPI memory interface with boot ROM capability, and 4-byte addressing support
  - 8-bit SRAM/ROM (FTMCTRL) with support up to 16 MiB ROM and 32 MiB SRAM.
  - Support for system in package with embedded SRAM/PROM (FTMCTRL).
  - Scrubber with programmable scrub rate for all embedded memories and external PROM/SRAM and SPI memories.
- System
  - On-chip voltage regulators for single supply support. Capability to sense core voltage for trimming of the embedded voltage regulator for low power applications.
  - Power-on-reset, brownout detection and dual watchdogs for safe operation. External reset signal generation for resetting companion chips.
  - Crystal oscillator support.
  - PLL for System and SpaceWire clock generation. In-application programming of system clock and peripheral clocks. System and SpaceWire clocks switches glitch free.
  - Low power mode and individual clock gating of functions and peripherals.
  - Temperature, precision voltage reference and core voltage sensor.
  - Precision voltage reference output for analog high-precision bias and measurement.
  - Programmable real-time accelerators for real-time execution capability
  - Enhanced programmable DMA controllers with support if-else statements. DMA transfers can be triggered on events such as interrupts or bits/register changing value.
  - Timer units with seven 32-bit timers including watchdog.
  - Multiple bus structures for non-intrusive debug, DMA transfers and memory scrubbers.
  - Atomic access support for GPIO control registers (AND, OR, XOR, Set&Clear).
  - Support for NVRAM (SRAM and/or PROM) embedded in package. Support for software boot and execution from embedded RAM for future package options.

# LEON3FT Microcontroller

- Peripheral access control.
- Embedded trace and statistics unit for profiling of the system.
- Peripherals
  - SpaceWire Router with support for RMAP and Time Distribution Protocol.
  - Redundant MIL-STD-1553B BRM (BC/RT/BM) interface.
  - CAN-FD bus controller with CANOpen support for remote boot.
  - Six UART ports, with 16-byte FIFO.
  - Two SPI master/slave serial ports.
  - SPI in Space hardware support for SPI Slave protocol 0,1 and 2
  - Two I2C master/slave serial ports.
  - PacketWire interface with CRC support.
  - 10/100 Ethernet interface
  - Up to 64 general purpose input and outputs (GPIO) with external interrupt capability, pulse generation and sampling.
  - Four single ended Digital to Analog Converters (DAC), 12bit, 3 MS/s, digital ramp generation support upto 25 MS/s.
  - Four Analog to Digital Converters (ADC), 11/14bit, 500/80kS/s, differential pre-amplifier, 4 differential or 8 single ended MUX inputs per ADC, and digital support for oversampling. Independent/simultaneous sampling on the four ADCs supported.
  - Hardware FPGA programmer and scrubber
  - Latch-up detection, to support e.g. space usage of commercial FPGAs and other COTS
  - Analog PWM controller for switching power converters and motor control
  - Programmable pulse-width-modulation DAC for analog precision outputs
  - System clock supervision
- I/O
  - Configurable I/O selection matrix with support for mixed signals, internal pull-up/pull-down resistors, schmitt-trigger input.
  - LVDS transceivers with extended common-mode, cold-spare and fail-safe support for SpaceWire, SPI4SPACE or SPI.
  - 20 Programmable analogue comparators
  - Dedicated SPI boot ROM support for configuration.
- Supply
  - Single 3.3V supply or separate Core Voltage 1.8V, and I/O voltage 3.3V.
- Radiation tolerance
  - Technology: 180 nm process, UMC Taiwan
  - Library: DARE+ Library version 5.7, IMEC
  - TID: 100 krad(Si) analogue full performance, functionality tested up to 300 krad(Si)
  - SEL: > 118 MeV-cm<sup>2</sup>/mg
  - SEU: Proven tolerance with hardened flip-flops and error corrections on all on-chip and external memories
- Package

# LEON3FT Microcontroller

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- 132-lead CQFP, 0.635 mm pitch, 25mm x 25mm, hermetically sealed with flat pins and insulating lead-frame for customer trim and form.
- Boot ROM and boot options
  - Remote boot directly via SpaceWire, CANopen, UART, SPI or I2C.
  - Direct software execution from onchip RAM, external SRAM, PROM or SPI memory.
  - Direct software execution from in package embedded memory.
  - Application Software Container (ASW) for boot software integrity check.
  - Boot via ASW from external SRAM, PROM or SPI memory.
  - Boot from redundant memory.
  - Fast boot option.
- System configuration
  - Reset and boot status.
  - Individual reset and clock control for digital and analog peripherals.
  - Remote reset and boot control.
  - Clock source and divide control for the core system, SpaceWire, SPI4SPACE, ADC, DAC MIL-1553 and FPGA scrubber clock domain.
  - Support for external system reset.
  - Support for external clock source for the system, SpaceWire, SPI4SPACE and MIL-1553.
  - Oscillator shutdown if oscillator not used.
  - Individual programmable brown-out levels.
  - Programmable LDO output level for low power mode.

# LEON3FT Microcontroller

## 2.2 Digital Architecture Overview

The system is built around three 32-bit AMBA AHB buses; the 32-bit Main AHB bus, the 32-bit DMA AHB buses and the 32-bit Debug AHB bus. The main bus connects the LEON3FT core with all other peripheral cores in the design as well as the external memory controllers. Several peripherals are connected through AMBA AHB/APB bridges where one of the bridges is integrated with the DMA controller.

The Debug AMBA AHB bus connects a UART serial debug communications link to the debug support unit and also to the rest of the system through an AMBA AHB bridge. A simplified block diagram is provided below, detailed memory map and AMBA AHB/APB bridge information are available in section 2.10.

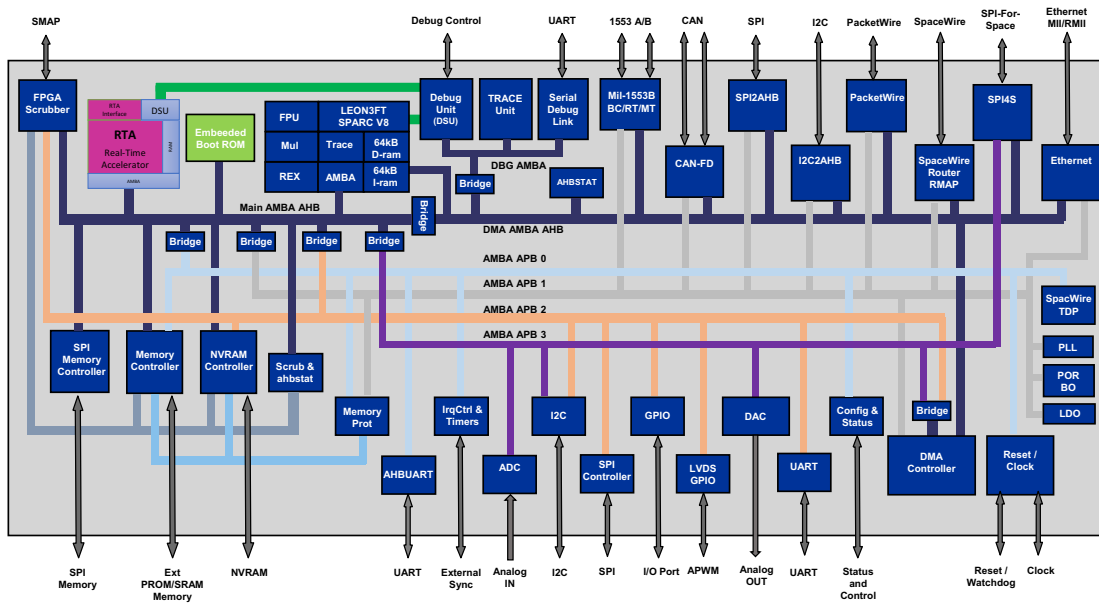


Figure 2. Simplified architecture and functional block diagram of the microcontroller (TBC)

### 2.2.1 Processor core and memory subsystem

The microcontroller implements a LEON3FT 32-bit processor core conforming to the IEEE-1754 (SPARC V8) architecture. The microcontroller is designed for embedded applications, combining high performance with low complexity and low power consumption. The LEON3FT core has the following main features: 7-stage pipeline with Harvard architecture, hardware multiplier and divider and on-chip debug support. The LEON3FT processor is enhanced with fault tolerance against SEU errors. The fault tolerance is focused on the protection of the on-chip RAM, processor register file and protection of external memory interfaces.

The LEON3FT integer pipeline is implemented with 31 register windows, SEU protection of register file with zero impact on software timing, and hardware multiply and divide units. The multiplier is a 32x32 hardware multiplier that performs operations in a single cycle. Floating-point operations are supported by a hardware floating-point unit.

Memory protection units are located on the AMBA system bus and on AMBA DMA bus. Each protection unit monitors access on the AHB bus. When an access is made to a protected area then the protection unit will assert a signal to the memory controller that will annul the operation and respond to the AMBA access with an AMBA ERROR response. Four areas can be protected on the system bus and four areas can be protected on the DMA bus.

# LEON3FT Microcontroller

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Exclusive write permission can be enforced for individual APB peripherals to protect interfaces from erroneous writes.

To protect tightly coupled instruction and data memory directly connected to the processor core from software the LEON3FT hardware watchpoints (located within the processor integer unit) can function as memory protection registers for both the instruction and data RAM.

## 2.2.2 Deterministic Operation

Several features are supported in the architecture in order to enhance it for embedded microcontroller applications:

- Support for SPARC V8E write partial %psr
- Support for SPARC V8E Alternative Window Pointer
- Support of the SPARC V8E Multiply step instructions

The microcontroller program execution is deterministic due to the microcontroller being cache-less, and AMBA accesses made by the processor being unaffected by other AMBA masters in the microcontroller. The processor uses separate EDAC protected instruction and data memories with fixed latencies. The instruction memory latency is 1 system clock and the delay for the data memory is 1 system clock. The local instruction and data memory in the system have the same latency and behaviour in the corrected as in the uncorrected case. This also applies to the CPU, so dynamic SEU handling schemes such as the LEON3FT pipeline restart on error options is not be used.

The microcontroller has 64 KiB of shared data RAM and 64 KiB of tightly coupled instruction memory connected to the processor. The tightly coupled instruction and data RAM can be accessed via the AMBA buses. This AMBA access can be used to upload new software into the instruction memory or read/write data to/from any AMBA master in the system. The access to the data memory will not affect or delay any access made by the processor on the AMBA bus. 64KiB of the instruction/data memory are available for sharing with the real-time accelerators.

The processor or any AMBA master can access the external PROM/SRAM or SPI memory controller for program execution or reading/writing data. The external SRAM memory can be protected by the scrubber located on the main system bus. The scrubber connected to the main system bus will block access for the processor to the external memories during scrub execution. The scrub rate can be configured and should be set to an acceptable rate for the mission. The scrubber access will not block the AMBA bus since masters and slaves on the main system bus support split transactions.

### 2.2.3 DMA controller

The microcontroller has two parallel DMA controllers. The GRDMAC2 core provides a flexible direct memory access controller. The DMA controller can perform burst transfers of data between AHB and APB peripherals at aligned or unaligned memory addresses. The GRDMAC2 core has multiple AHB master interfaces for access to AHB peripheral bus and direct access to all APB slaves. The GRDMAC is able to perform programmable sequences of data transfers between any slaves in AMBA address space. The controller is able to transfer data between peripherals and memory and between memory areas. If the accessed memory is internal or external does not matter, as long as the memory is mapped into AMBA address space reachable from the AHB bus where the DMA controller is mapped.

The DMA controller configuration registers are accessible through an APB interface. Each DMA controller can be flexibly configured by means of two descriptor chains residing in main memory: a Memory to Buffer (M2B) chain and a Buffer to Memory (B2M) chain. Each chain is composed of a linked list of descriptors, where each descriptor specifies an AHB address and the size of the data to read/write, supporting a scatter/gather behavior.

Once enabled, the DMA controller will proceed in reading the descriptor chains, then reading memory mapped addresses specified by the M2B chain and filling its internal buffer. It will then write the content of the buffer back to memory-mapped addresses by elaborating the B2M descriptor chain.

The DMA controller supports a simplified mode of operation. In this mode of operation only one descriptor is present for each of the M2B and B2M chains. These two descriptors are written directly in the core's register via APB.

The DMA controller will offload the CPU and provide DMA capabilities to peripherals and communication interfaces in the microcontroller design that do not have an internal DMA engine. The DMA controller can be programmed to initiate DMA transfers on events, such as interrupts, to the GRDMAC controller to achieve timely readouts of values. An example of use can be found the detailed description of the DMA controller in section 28.

### 2.2.4 Interrupt handling

The microcontroller supports interrupt time stamping and interrupt handling mechanism to ensure that a fixed number of clock cycles occurs between the assertion of an interrupt and the processor's jump to the trap table. Depending on the software application, several types of time stamping can be of interest:

- Timestamp when interrupt line is raised from peripheral IP core. This time is of particular importance when time needs to be synchronized with an external event.
- Timestamp when processor acknowledges the interrupt. This stamp is primarily of interest in system characterization where users may want to measure the time it takes for the processor to divert execution flow to the interrupt service routine after the processor has discovered the pending interrupt.
- Timestamp when software enters ISR. This timestamp is typically taken by software by reading a timer register when the ISR is entered.

Interrupt time stamping is controlled via the Interrupt Timestamp Control register(s) described in section 40. Each Interrupt Timestamp Control register contains a field (TSTAMP) that contains the number of timestamp register sets that the core implements. A timestamp register sets consist of one Interrupt Timestamp Counter register, one Interrupt Timestamp Control register, one Interrupt Assertion Timestamp register and one Interrupt Acknowledge Timestamp register.

Software enables time stamping for a specific interrupt via an Interrupt Timestamp Control Register. When the selected interrupt line is asserted, software will save the current value of the interrupt timestamp counter into the Interrupt Assertion Timestamp register. When the processor acknowledges the interrupt, the Interrupt Timestamp Control register will be set and the current value of the timestamp

# LEON3FT Microcontroller

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counter will be saved in the Interrupt Acknowledge Timestamp Register. The difference between the Interrupt Assertion timestamp and the Interrupt Acknowledge timestamp is the number of system clock cycles that was required for the processor to react to the interrupt and divert execution to the trap handler.

## 2.2.5 Reset and software boot

The reset default behavior for all included cores, except the LEON3FT processor, is to enter an idle state upon reset. The internal reset signal will be asserted as a result of power-on. In the idle state the cores do not initiate any transactions and does not keep any signals in output mode. This is of particular concern for bidirectional signals to prevent contention.

The LEON3FT processor will normally start executing from a predefined start address 0x0000000 at reset. The start of execution can be prevented by assertion of an external break signal. If the break signal is asserted then the processor will enter power-down mode after reset. This will allow software upload from an external entity that can then start the processor at a dynamically specified address, by writing to the interrupt controller's register interface. Processor can optionally be forced via bootstraps to be forced to start from external PROM, SRAM, MRAM, or SPI memory. This mode could be used if the application requires separate boot code than the one existing in the LEON3FT microcontroller boot ROM. Boot addresses for external PROM and SPI memory are defined in section 2.10.

A boot ROM application is placed at address 0x00000000 and is normally executed after reset. The boot application supports system functions controllability via external bootstrap registers. The application always starts executing after reset and checking the value of external bootstrap signals. Based on these signals the processor performs tasks such as load software to internal RAM from an external memory device, enable remote access via SpaceWire, CAN-FD, SPI, UART or I2C. See section 3.1 for more information about bootstrap options for the boot ROM.

A protocol to guard against the system trying to boot using a corrupt boot image is implemented using a protected image format containing an image header, boot code, data checksum and header checksum, see section 51. Extra protection can be enabled via bootstraps by reading identical images from redundant memories but needs to be configured before booting via an external boot strap.

Self-test and diagnostic test of the CPU and internal RAMs can be enabled via bootstraps. The internal ROM will check for Stuck-At and Transition errors in local instruction and data ram. Stuck-At or Transition error(s) will result an error reported in the boot report, see 51.2.5.

## 2.2.6 Direct boot from external memory

Custom boot options are supported via bootstrap options to bypass the internal boot ROM code. The LEON3FT microcontroller can be configured to boot directly from external ROM, external SRAM, external SPI Memory or internal NVRAM in package (GR716B with internal NVRAM is currently not available).

## 2.2.7 Remote access and control

The microcontroller can be accessed and controlled by an external control unit via SpaceWire (RMAP), CAN FD (CANOpen), UART, SPI or I2C without using processor support. Full access, except for debug features on the debug AMBA bus, will be granted to SpaceWire, CAN-FD, UART, SPI or I2C if enabled at startup via bootstraps after reset:

- SpaceWire: Remote Memory Access Protocol (RMAP) provides full remote access to the entire AMBA address space of the microcontroller. See section 33 for more information
- CAN-FD: Support for remote access via CANOpen PDOs provides full remote access to the entire AMBA address space of the microcontroller. See section for GRCANFD for more information

# LEON3FT Microcontroller

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- UART: Support for reading and writing to register via special protocol over UART provides full remote access to the entire AMBA address space of the microcontroller. See section for AHBUART for more information
- SPI: Support for reading and writing to register via special protocol over SPI provides full remote access to the entire AMBA address space of the microcontroller. See section for SPI2AHB for more information
- I2C: Support for reading and writing to register via special protocol over I2C provides full remote access to the entire AMBA address space of the microcontroller. See section for I2C2AHB for more information

All the communication interfaces above can be implemented to be functional directly after the microcontroller leaves reset, no initialisation from the processor is required. The communication links can also be disabled by the processor, a feature that can be required for safety.

When debugging the microcontroller, the DSU is used to load software and initiate the program counter. In the case when new software is remotely updated via SpaceWire, CAN-FD, UART, SPI or I2C, a special feature in the interrupt handler is implemented to restart the system and to start execution of new software. For more information see section 40.2.7 to 40.2.9.

## 2.2.8 Pin sharing

A I/O switch matrix allows most of the GR716B microcontroller pins functionality to be configurable and to be shared between several peripherals. The I/O switch matrix provides a flexible solution where enabling one core changes the I/O switch matrix so that the current core gets connected to I/O pads.

The microcontroller contains on-chip ADC/DAC. The on-chip ADC/DAC requires special mixed digital and analog I/Os. The mixed digital and analog I/O are controlled via configuration registers and needs to be set to analog mode when an ADC or DAC is going to be used.

SPI4SPACE supports on-chip LVDS transceivers and CMOS I/Os. The redundant SPI4SPACE channel can be accessed via CMOS pins and the primary SPI4SPACE channel is accessed via on-chip LVDS.

## 2.2.9 Integrated ADC and DAC

The ADC digital control logic supports functions to control the on-chip ADC and to offload the processor. Support for automatic oversampling on all channels, sample sequencer and digital level comparators are examples of features integrated to offload the processor. The integrated DMA controller can also be used to off-load the processor by automatic transfers of sample values to/from the integrated data and ADC/DAC.

The DAC digital control logic supports functions to synchronize DAC output to events and generate programmable output waveforms. The main purpose of the programmable waveform feature is to support DC/DC applications.

## 2.2.10 FPGA Configuration and Supervision

The FPGA configuration and supervisor in GR716B can program an external FPGA, and scrub its configuration memory to prevent accumulation of errors in the configuration memory.

The FPGA Configuration and Supervision in GR716B is compatible with the Kintex UltraScale and Virtex-5 Xilinx FPGA families. It accesses the FPGA configuration memory externally through the SelectMap (SMAP) interface, which provides better performance in comparison with JTAG, due to the parallel data access. For more information see section 55.



### 2.2.11 Real-time accelerator and system overview

The real-time accelerator can handle stringent cycle-by-cycle real-time applications which is useful in, e.g., switching power and motor control applications. The real-time accelerator (RTA) provides user flexibility to support a wide variety of real-time critical applications addition, general hardware – directly accessible from the RTAs – is implemented to execute all real-time functions that are time critical down to system-clock cycle level, such as PWMs, ADC, DAC, UART, I2C, SPI and GPIOs

The Real-Time Accelerator (RTA) implements a LEON3FT 32-bit processor configured with minimum number of register windows, which is complemented by a RTA Task Manager (RTM) and a RTA time Stamp Manager (RSM). The RTA Task Manager (RTM) enables time critical applications which interrupt/event depended to execute code in the RTAs LEON3FT processor in one execution level", never using interrupts. The RTA time Stamp Manager (RSM) capture consecutive events and automatically calculates the difference in time between events. Examples of real-time applications targeted by the Real-Time Accelerator (RTA):

- Multiple switching power converters such as the buck and boost topology
- Complex switching power converters such as full-bridge topologies
- Motor and magnetorquer control
- High voltage and high current generators
- Power system monitoring
- Latch-up detection, to support e.g. space usage of commercial FPGAs and other COTS

The LEON3FT in the RTA can still be programmed to use the standard software execution flow and interrupts to work in systems with lower or no real-time requirements. Examples of applications with lower or no real-time requirements targeted by the Real-Time Accelerator (RTA):

- Simple Motor control
- Latch-up detection, to support e.g. space usage of commercial FPGAs and other COTS
- Advanced DMA transfers
- Interface emulation such as UART or I2C via direct access to GPIO control registers from the RTA

The real-time system is built around two data buses and an event bus. The real-time system is separated from the AMBA system to guarantee fast access by the RTA applications executed in the Real-Time Accelerator (RTA), is presented in Figure 3. The real-time events generated in any function or interface connected are distributed on the RTA Event Bus across the chip. Each Event will be configurable and distributed to all necessary real-time functions in any real-time blocks where it may be needed to provide synchronization on clock cycle-by-cycle level. Real-time data and time-stamps are distributed on the RTA data bus. The RTA data bus has no defined protocol and it is up to the application to configure the transmitter function/interface and to interpret the information received.

# LEON3FT Microcontroller

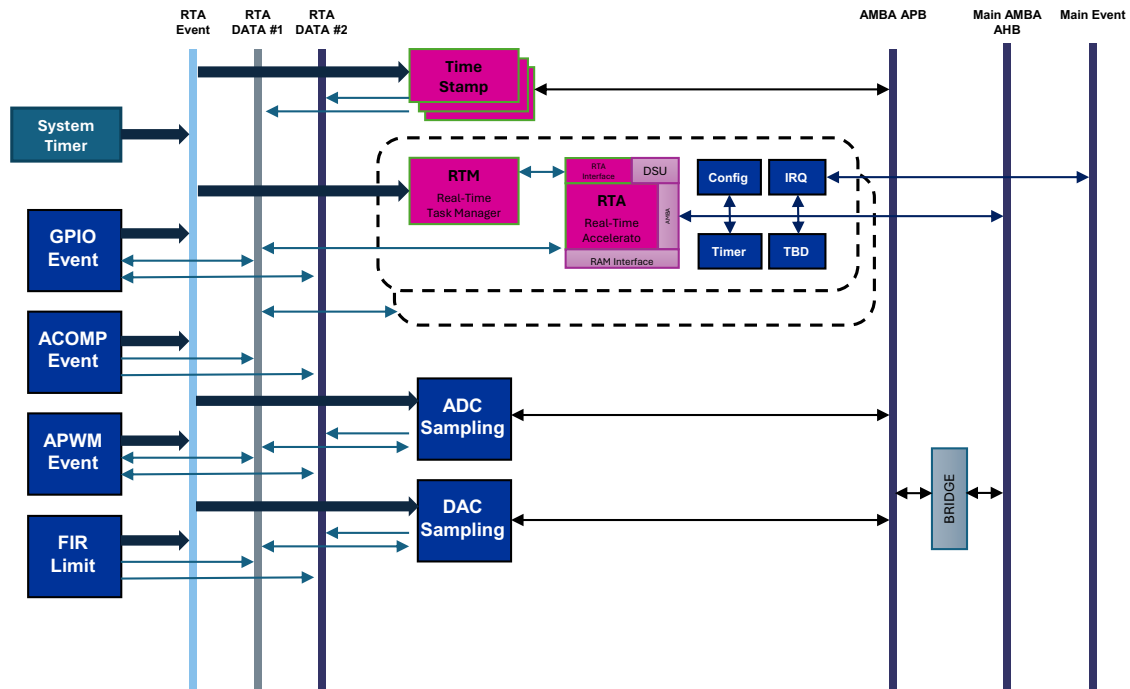


Figure 3. Simplified architecture and functional block diagram of the real-time system

Functions and interfaces connected to the real-time system:

- Analog comparators including FIR filters
- Analog to Digital Converter
- APWM blocks (PWM for Analog applications)
- Digital to Analog Converters
- UART/I2C/SPI/GPIO

The RTA processor will be kept in reset with the clock disabled after reset. The RTA needs to be reset and enabled from a user application on the main processor or via remote access before software can be executed on the RTA. The RTA has a local interrupt controller with a special feature to restart the real-time system and to start execution of new software on the RTA processor.

When debugging the microcontroller, each individual RTA's DSU can be used to load software and initiate the program counter. For more information see section 40.2.7 to 40.2.9. Each RTA has a separate DSU unit.

# LEON3FT Microcontroller

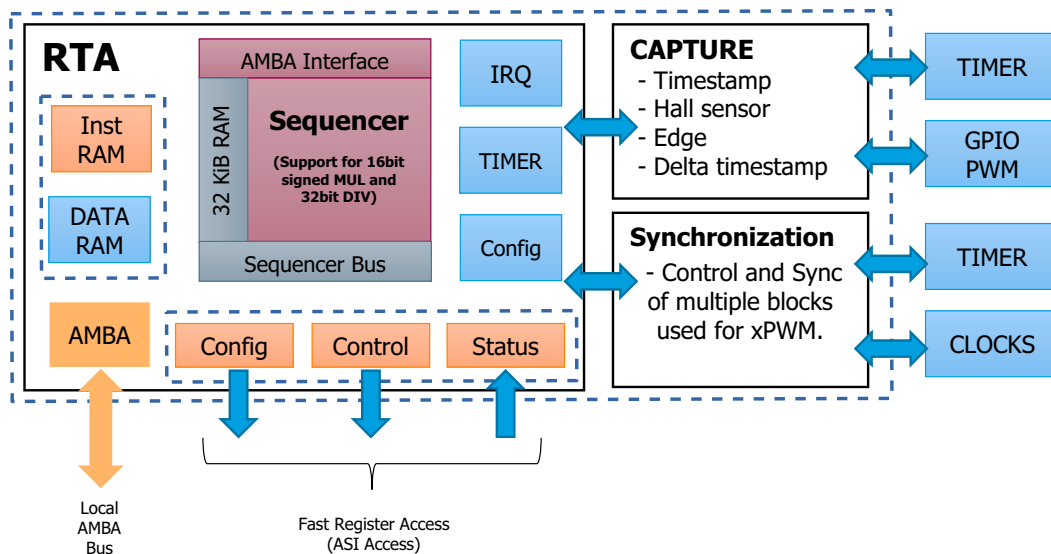


Figure 4. Simplified architecture and functional block diagram of the RTA and connections

The Real-Time-Accelerator (RTA) includes:

- LEON3FT processor core with 2 register windows and support for 32bit multiplier and accumulator.
- Separate Data (16KiB) and instruction (16KiB) memory for single cycle execution of instructions
- Separate Debug Unit with instruction trace
- Separate system timer possible to synchronize to system timer
- IRQMP local interrupt controller with start/stop/reset control
- RTA Task Manager (RTM) and interrupt time stamp functionality
- AHB/AHB bridge with access to control to separate the RTA system from the main GR716B system
- AHB bridge with direct access to following peripherals
  - ADC
  - DAC
  - I2C
  - SPI
  - GPIO
  - UART
  - PWM
- The RTA system does not have access to other parts of the design due to security reasons.

The RTA module is an independent LEON3FT subsystem and can execute software in parallel with the main LEON3FT processor in GR716B. The RTA subsystem can access 32KiB of tightly coupled memory protected by EDAC to ensure single cycle instruction execution. The RTA implements 2 sets of register window and supports interrupts.

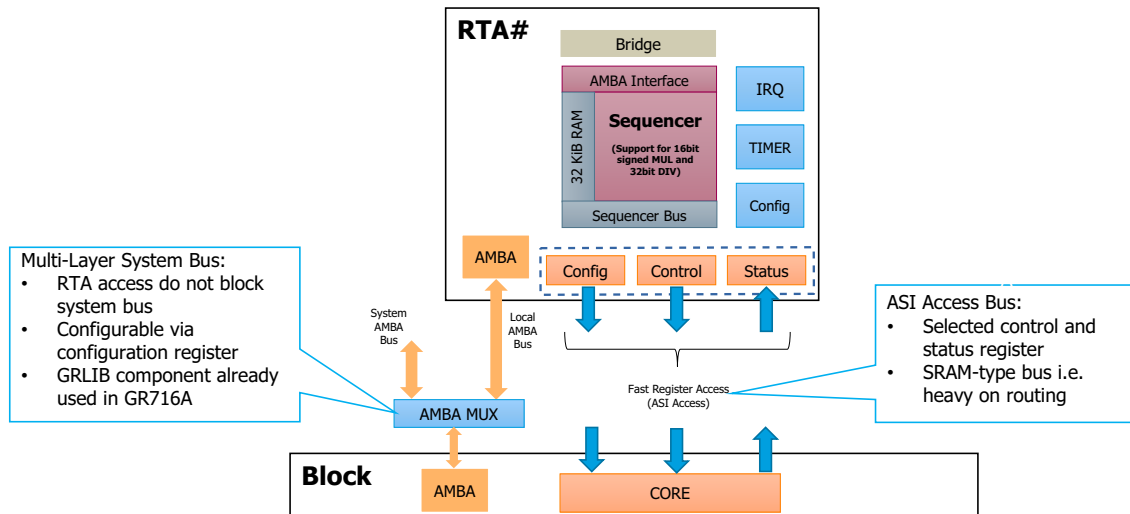


Figure 5. Real-Time-Accelerator (RTA) provides fast access to peripherals via processor ASI interface. Real-Time-Accelerator (RTA) can also access peripherals via system bus if granted by the system.

Fast access to peripherals from the RTA / LEON3FT IP CORE is performed via parallel AMBA bus structure. The benefit from using parallel bus structure is that each RTA can make independent and parallel accesses to peripherals in the system without having to wait for access.

Another benefit from using shared or parallel buses is that all processors use the same register address space, and all processors can use the same programming model already supported by BCC version 2.2.0 or later.

## 2.2.12 Switching power applications

The overall architecture real-time execution capability for DC/DC applications is secured by tightly integration between the Real-Time-Accelerator (RTA), see 2.2.11, and the hardware functionality described in this chapter 2.2.12. It supports at least 4 independent DC/DC converters running at power switch frequency up to 500kHz. Peak-current control mode is supported by on-chip analog comparator, and the voltage regulation is controlled by user-specified software in RTA.

As great user flexibility as possible is supported for a wide variety of power-supply applications, which is fulfilled by RTAs user-specified software. And generally configurable PWM hardware, directly accessible from the RTAs, is implemented to execute all real-time functions that are time critical down to system-clock cycle-by-cycle level. Further details of these implementations are presented in section 53.

## 2.2.13 Motor control applications

In motor control applications, hardware support for complex switching power converts can be combined with the ability to configure ADC measurements on 3 analog channels with simultaneous sampling time point for optimum motor regulation.

Architecture support for motor applications:

- At least 4 BLDC/MSM motors in PWM mode is supported
- Up to 4 analog channels with simultaneous sampling time point for optimum motor control
- Resolver interface, digital generation of a sine-wave
- Precision reference voltage for high precision measurements

Further details of motor control is presented in section 53.

# LEON3FT Microcontroller

## 2.2.14 External synchronization and alarm generation

GR716B can generate an external synchronization signal to other devices, or synchronize internal logic and counter to a received synchronization input. The external synchronization generation capabilities enables the user to synchronize multiple GR716B devices in switching-power and motor-control applications, etc.

For more information see section 53.6 and 53.7.

## 2.2.15 Fast analogue comparators and Latch-up detection support

There will be analog comparators connected to each of the 16 ADC input pins and 4 DAC output pins. The analog comparator is configurable to fix-voltage trig levels, and can catch analog trig events, see figure 6.

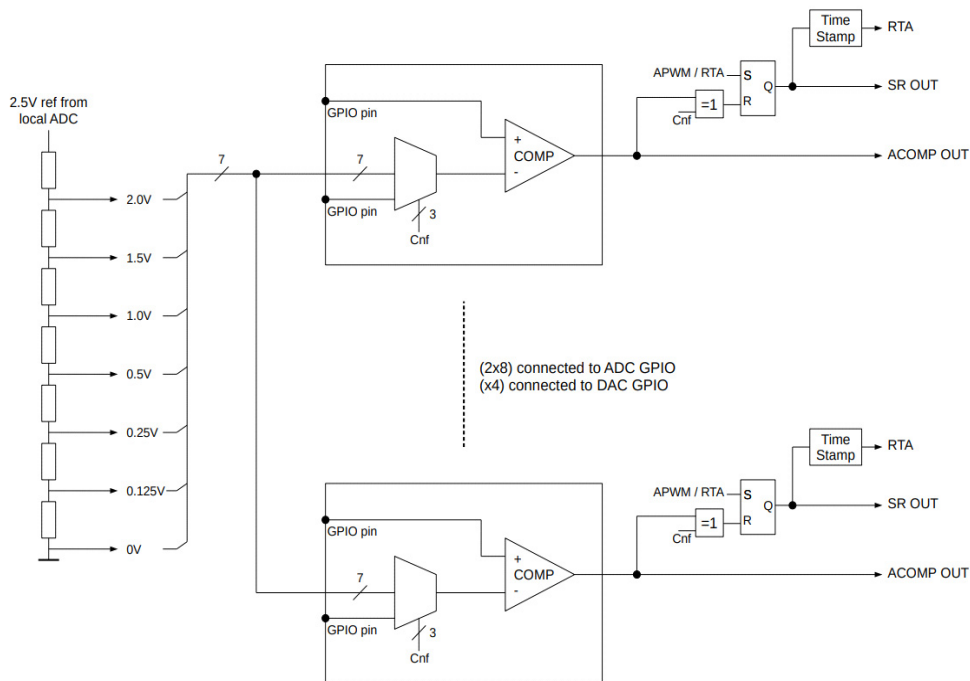


Figure 6. Functional schematic of ACOMP, which can be used for catching analog events

Each analogue comparator can have its output configured to the input of the following functions:

- PWM peak control in switching power applications
- General FIR filter for latch-up detection applications

The general FIR filter with binary taps has application areas such as:

- Flexible programmable latch-up detectors
- Basic FIR filter functions
- Flexible patterns recognition in communications, sensors, etc
- Continuous background-monitoring with alarm trig on wave patterns, sensors, etc.

For more information see section 16.

## 2.2.16 Digital Modulator for Analog Precision DAC Outputs (APWM\_DAC)

The APWM\_DAC block provides a digitally modulated output signal, to be low-pass (LP) filtered on PCB. It gives an analog precision signal after the LP-filter that has higher resolution than the 12-bit

# LEON3FT Microcontroller

current-output DAC presented in sections 15 and 57.7. The maximum bandwidth will be lower, e.g. in the range 0.1 to 100 kHz, depending on priority of bandwidth, analog ripple, filter complexity, etc, in the design of the PCB LP-filter. The modulator can be configured as a first or second order modulator, see figure 7, and requires a second or third order LP-filter, respectively.

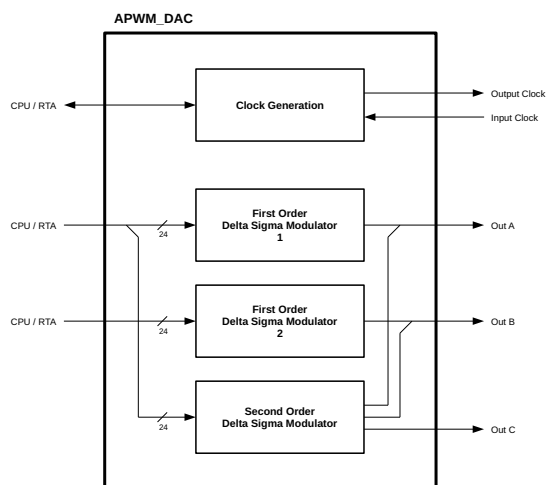


Figure 7. Functional diagram of APWM\_DAC

In the simplest form, the LP-filter can be two cascaded RC-links directly connected to the GPIO pin on GR716B, which means that VDD\_IO acts as analog reference voltage. If better accuracy is required, a CMOS buffer can be added on PCB, with VDD connected to a precision reference voltage.

The GR716B on-chip implementation supports full 24-bit DAC resolution, meaning that it will be the PCB analog implementation that sets the analog performance limits. E.g., re-clocking the GR716B modulator output in a clocked CMOS register on PCB, with VDD connected to a precision reference voltage, will further improve the analog performance. And to implement the CMOS registers with differential signal path, going into an op-amp based differential LP-filter, will provide excellent performance.

In general, the better analog performance that is required, the more complexity will be needed in the PCB filter implementation. See section 54 for a more detailed presentation of APWM\_DAC with application examples of PCB filters.

## 2.2.17 System clock fault detection support

To detect failure on the system clock, which can affect the any external regulation loops a system clock supervisor has been built-in monitor and detect loss of system clock. The detector can be optional configured to alert the main processor or to disable regulation loops. This detector uses independent on-chip clock generator (ring-oscillator) as frequency reference.

The upper and lower frequency limits, to be checked by the Clock Detector, are configurable by user. This may be useful in cases where the frequency needs to be checked to be within a more narrow span than the temperature drift of the on-chip ring-oscillator. In such cases, the user monitors the temperature, and continuously configures the limits accordingly. Alternatively, in cases where a larger detection frequency span can be allowed, these limits can be set wide enough to allow for the whole temperature drift.

Finally, health status of the on-chip ring-oscillator can also be monitored. It is done by polling the internal status of the Clock Detector block.

For more information see section TBD.

### 2.2.18 Program and scrubber support of COTS FPGA

The GRSCRUB is an FPGA configuration supervisor responsible for programming and scrubbing the FPGA configuration memory to prevent accumulation of errors. The GRSCRUB controller is currently compatible with the Kintex UltraScale and Virtex-5 Xilinx FPGA families. The controller can be set to scrub the entire FPGA configuration memory or just a defined memory area.

GRSCRUB accesses the FPGA configuration memory through the SelectMap interface. In addition, the GRSCRUB accesses through an AMBA bus a Golden memory that can be external ROM/RAM or SPI FLASH. The original configuration bitstream is stored in the Golden memory, and it is used both to configure the FPGA at start-up and to repair the FPGA configuration memory in case of errors. The Golden memory also stores the mask data and the Cyclic Redundancy Check (CRC) codes used to check the configuration bitstream integrity.

For more information see reference document [FPGA] and section 55.

### 2.2.19 Debug and statistics

An external debug host can access the microcontroller Debug Support Unit (DSU) via UART (RS232). The DSU can be used to access instruction trace buffers and registers of the LEON3FT processor. The DSU has also support for tracing AHB accesses that can be used for performance monitoring. For more information about the functionality see section 20. Since the DSU is connected to an AMBA AHB bus and is accessed via debug communication links also connected to AMBA AHB, all debug accesses will generate traffic over AMBA AHB. In order for the debugging to be completely non-intrusive this debug traffic is separated from the non-debug AHB traffic.

The microcontroller includes a LEON3 statistics unit that allows the debugger to count a wide range of events without interrupting or controlling execution. See section 41 for more information about the LEON3 statistics unit.

The GR716B microcontroller have one dedicated Serial Debug interface. The Serial Debug unit is directly connected to the AMBA debug bus. The Serial Debug unit have a unique AMBA address described in chapter 2.10.

The debug interface is intended to be used during software development and have direct access to the internal state of the processor and trace buffers. This interface can be disabled during mission via external pin configuration i.e. tie DSU\_EN to low.

The Serial Debug interface unit is fully described in section 48

### 2.2.20 AMBA Error detection

The microcontroller includes status registers to store information about AMBA AHB accesses triggering an error response on the Main and DMA AMBA bus. Error response on the AMBA main bus is stored in either the memory scrubber unit or AHB Status unit 2. Error response triggered on the DMA bus is stored in the AHB Status unit 1.

The Main AMBA bus can be configured to fetch all AMBA error responses in the memory scrubber, see chapter 7.3.3. The system default configuration is to only fetch AMBA errors from the external memory controllers in the memory scrubber. All other AMBA error responses on the Main bus will be fetched in the AHB Status unit 2.

### 2.2.21 RTA Debug and AMBA Error detection

The external debug link a debug host can access and debug the RTA unit via separate Debug Support Unit (DSU). The RTAs Debug Support Unit (DSU) has limited instruction trace and support hardware break points.

The RTA Debug Support Unit (DSU) is connected to the internal AHB debug bus.

Each RTA also includes a control unit to monitor and detects AMBA Errors.

# LEON3FT Microcontroller

## 2.2.22 Internal communication

Triggers, events and synchronization signals that require immediate response are distributed outside the internal AMBA bus structure. This section explains the different connections next to the internal AMBA structure.

Signal connections are visually shown in figure 8 and described in table 6 in this section.

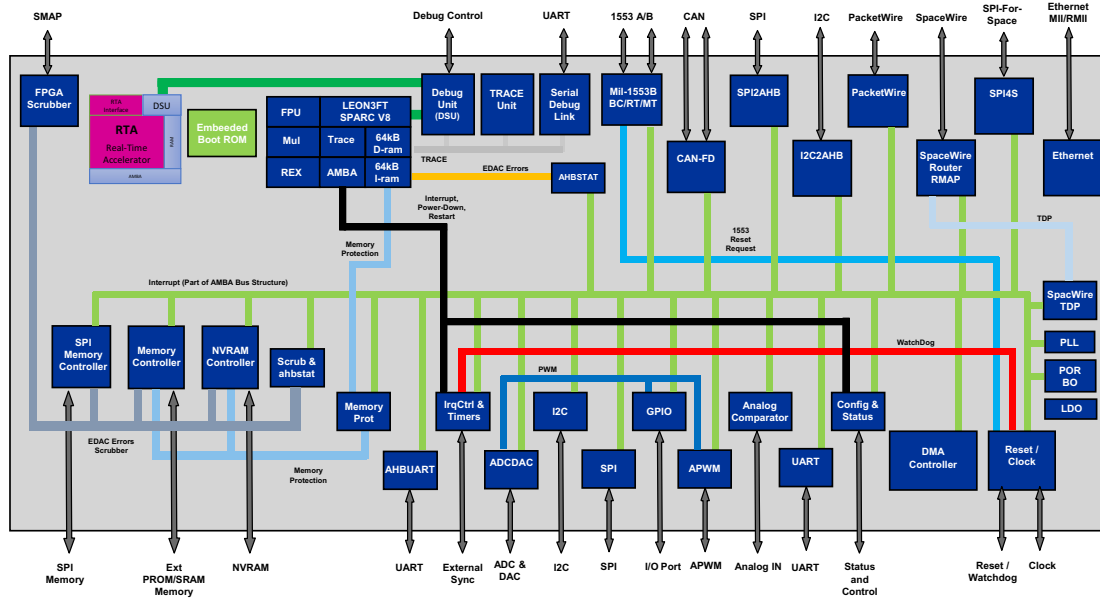


Figure 8. Internal communication paths outside AMBA bus structure (TBC)

Table 6. Internal communication paths outside the AMBA bus structure

Internal bus name	Connecting functional blocks	Description
EDAC Error	AMBA status, local instruction memory and local data memory	Connection for monitoring of correctable errors signaled from the internal data and instruction memory.
EDAC Error Scrubber	AMBA status functionality in scrubber, external memory controller and NVRAM controller	Connection for monitoring of correctable errors signaled from the memory controller and NVRAM controller.
Interrupt Bus	All blocks connected to the internal AMBA structure	Connection for distributing events from/to all peripherals and digital functionality. The internal interrupt bus distributes all 64 unique interrupts IDs in table 19. The interrupt bus is used to program event driven functions e.g. the DMA channel 0 to respond to a specific Interrupt ID in table 19.
Memory protection	Protection unit, external memory controller, NVRAM controller, local instruction memory and local data memory	Connection for blocking write access to protected areas. Protection unit grants or denies the ongoing AMBA access via the memory protection bus.



# LEON3FT Microcontroller

Table 6. Internal communication paths outside the AMBA bus structure

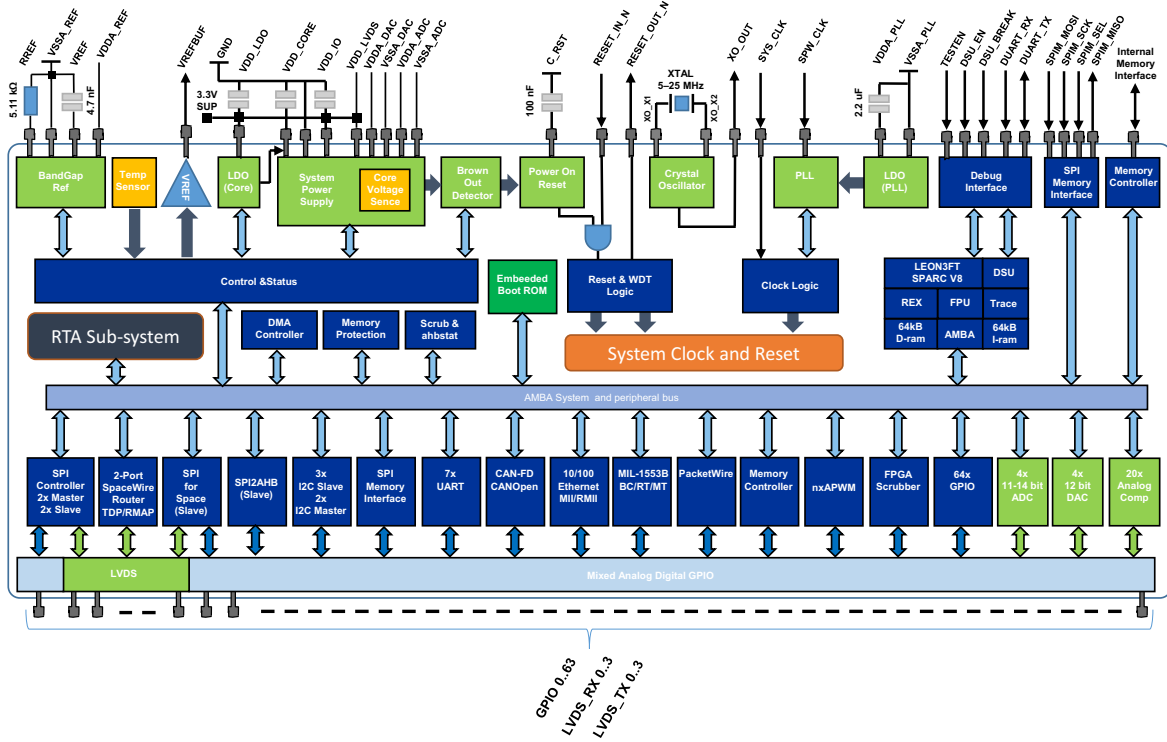
Internal bus name	Connecting functional blocks	Description
Processor Interrupt, Power Down and Restart	LEON3FT, Interrupt controller and Primary Clock gating unit.	The interrupts generated on the interrupt bus are all forwarded to the interrupt controller. The interrupt controller prioritizes, masks and propagates the interrupt with the highest priority to the processor. This bus is also used for request for Power-Down of the processor and restart of the processor. Power down request from the processor is described in section 17.2.16 and reboot is described in section 40.2.7.
Watch Dog	Timer unit 0 and reset request logic	Watch dog timer unit drives a watchdog signal on this bus to request restart of the system. Watch dog functionality is described in section 35. User can override reset request with control register described in section 7.3.
1553 Reset Request	MIL-1553 peripheral interfaces and reset request logic	MIL-1553B codec request for reset of MIL-1553B interface support.
TDP	MIL-1553B and SpaceWire	Internal bus for communication between the SpaceWire Time Distribution Protocol core and the SpaceWire interface or the MIL-1553B interface. For more information see section 34.
DSU	DSU and LEON3FT	Debug interface for direct access and control of the LEON3FT processor from debug interface.
APWM	APWM, GPIO, DAC and ADC	APWM synchronization tick outputs. Ticks or events can be programmed individually for each PWM to be generated at PWM compare points, PWM period match, or not generated at all. PWM ticks are distributed in the system to synchronize events to the PWM output.
L3STAT	To LEON3 Statistical Unit	Connection for counting events in the system defined in table 544 under section "Implementation specific events" and in section "Events generated from REQ/GNT signals". Bus is only passively listening.
TRACE	From AMBA infrastructure to Trace buffer	Main and DMA AMBA buses are routed to the trace buffer. Trace buffer is passively listening to signals.

# LEON3FT Microcontroller

## 2.3 Analog Architecture Overview

The analog/mixed and power-supply IP blocks are presented here. In figure 9, a simplified block diagram shows these blocks and their analog and power interconnections in the GR716B microcontroller.

Figure 9. Simplified block diagram of the analog/mixed and power-supply IPs in the GR716B microcontroller.



Generally, note that when the crystal oscillator (XO) and PLL are used to generate the GR716B microcontroller clocks, these two blocks must be correctly connected and configured to obtain correct digital functionality of the GR716B microcontroller. Moreover, to obtain correct analog functionality of the GR716B microcontroller, e.g., the internal LDOs, the voltage and current references, set by VREF and RREF, must be correctly connected and configured, since they provide the GR716B microcontroller with the internal references and bias currents required by the whole chip in figure 9. Therefore, the VREF capacitor and RREF resistor should always be connected.

### 2.3.1 Reset and Brownout detector

The Reset and Brownout detector blocks supervise the supply voltages as shown in figure 9. The Reset block provides reset of the internal GR716B microcontroller logic. The internally generated reset is available externally as a 3.3V CMOS output, RESET\_OUT\_N, which is low when V<sub>DD\_CORE</sub> is too low. There is also a reset release delay at power up, starting to count when V<sub>DD\_CORE</sub> goes above its reset threshold level.

The Brownout detectors are intended to be used as pre-warnings to the GR716B microcontroller that a supply voltage has started to go down, so the CPU can perform a well-controlled system shutdown before the reset level is activated. The Brownout detectors are implemented as one detector per supply to be supervised, and they have individually programmable threshold levels. Each Brownout detector can generate interrupt, which typically shuts down the system in a controlled way.

### 2.3.2 Crystal Oscillator (XO)

The XO is supplied by the LEON3FT microcontroller core voltage, V<sub>DD\_CORE</sub> (1.8V), and the oscillator output is a 3.3V CMOS output and is available on external pin. When the XO output is used as system clock, the power-on reset block must have long enough reset-release delay, set by C\_RST, to

# LEON3FT Microcontroller

ensure that the XO has started before the reset is released. Therefore, the recommended value of  $C_{RST}$  is at least  $100\text{nF}_{\text{nom}}$ , see figure 9.

## 2.3.3 PLL

The PLL is supplied by 1.8V from an internal LDO, which should have an external decoupling capacitor between the PLL supply pins. This supply pin shall be left open, with exception of this decoupling capacitor. The PLL provides several internal clock outputs, typically used as clock for the SpaceWire interface, internal system clock, etc. The PLL input clock is a 3.3V CMOS input, SPW\_CLK, to which the XO-oscillator clock output can be directly connected, or any other clock signal generated on PCB fulfilling the electrical specification of this input. The PLL input clock is allowed to be asynchronous to any other clocks in the GR716B microcontroller, and it has no guaranteed phase relation to the internal clocks output from the PLL.

## 2.3.4 Precision Voltage Reference

The internal analog reference generation is supplied by  $V_{DDA\_REF}$  and  $V_{SSA\_REF}$ . This supply needs to have the best voltage integrity on the chip. Therefore, no fast load-current steps are allowed on this supply. It is essential that especially this supply has good PCB decoupling/filtering (connected directly across  $V_{DDA\_REF}$  and  $V_{SSA\_REF}$ ) in order to not feed external disturbances from PCB supplies into this supply. The analog internal references are generated in two steps. First, a reference voltage is generated by an on-chip bandgap reference, which should have an external decoupling capacitor, 4.7nF, on the VREF pin to  $V_{SSA\_REF}$ . Second, this reference voltage is buffered and put out on the VREFBUF pin.

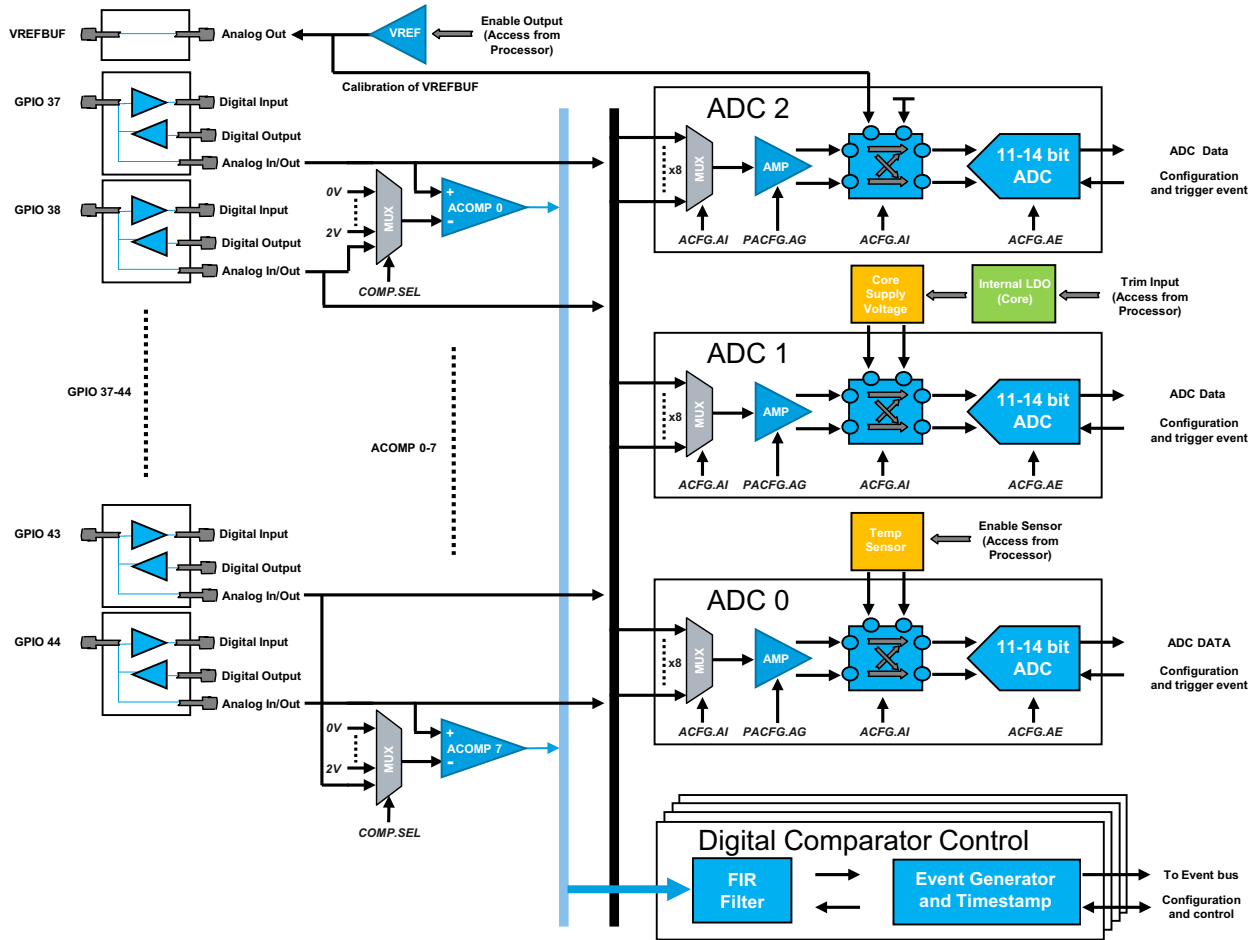
The internal reference voltage is also used by an internal current generator, which puts this voltage across an external reference resistor, RREF on PCB, to generate a precision reference current. Since this reference current is used to generate both the current reference to each DAC and the internal bias currents required by several other internal blocks, RREF *cannot* be chosen arbitrarily to get any desired DAC full-scale value. It needs to be 5.11k $\Omega$  (or 4.64k $\Omega$  + 464 $\Omega$ , which are more frequently used standard values).

# LEON3FT Microcontroller

## 2.3.5 Internal ADC

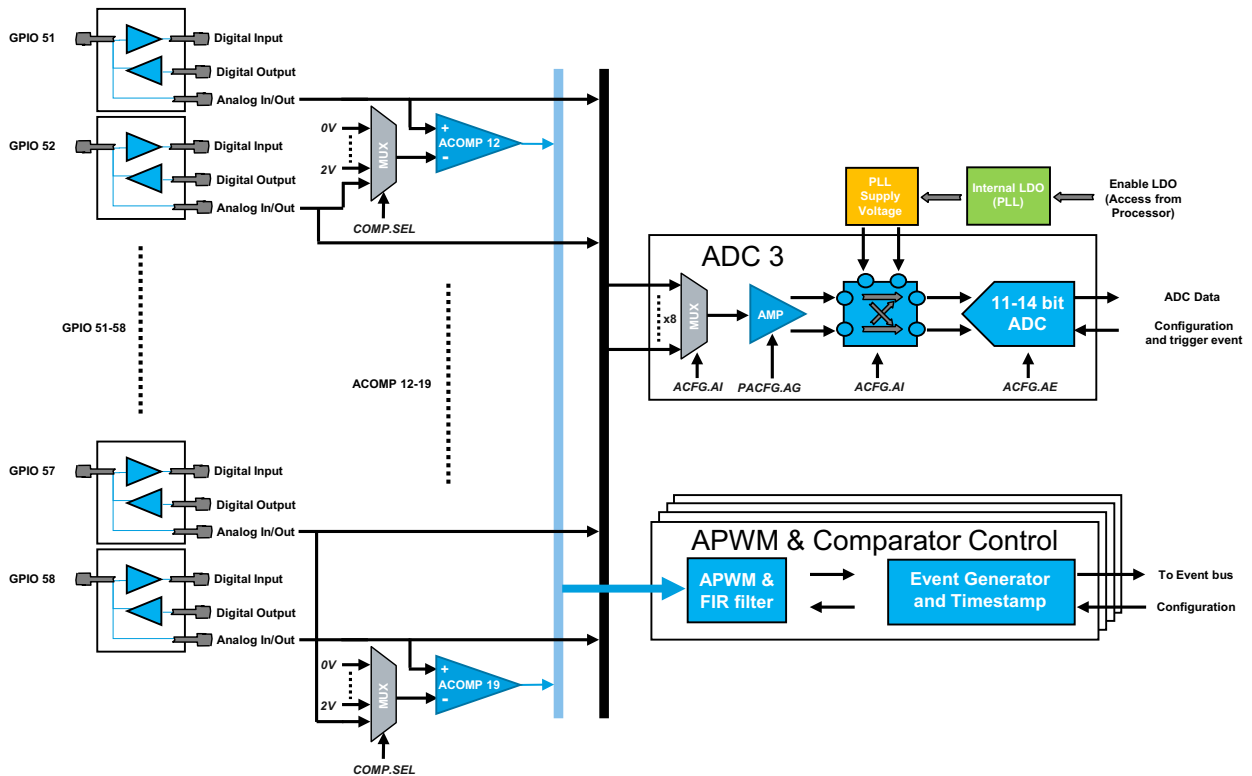
There are four independent ADC blocks. Each ADC can operate as 11/14bit at 500/80kSps, and has an analog MUX on its input, which means that one MUX channel at a time can be measured.

Figure 10. Shared external connections and internal fast analog comparator connections for ADC0, ADC1 and ADC2.



# LEON3FT Microcontroller

Figure 11. External connection and internal fast analog comparator connections for ADC3.



Each ADC can be programmed to single-ended measurement on one analog input pin (range 0V to 2.5V), or to differential-input measurement (differential range -2V to 2V) using two input pins per channel. In-between the ADC and MUX, there is a fully differential pre-amplifier, which has three programmable gain settings (x1, x2, x4), or can be by-passed. It is to be used together with the differential ADC mode.

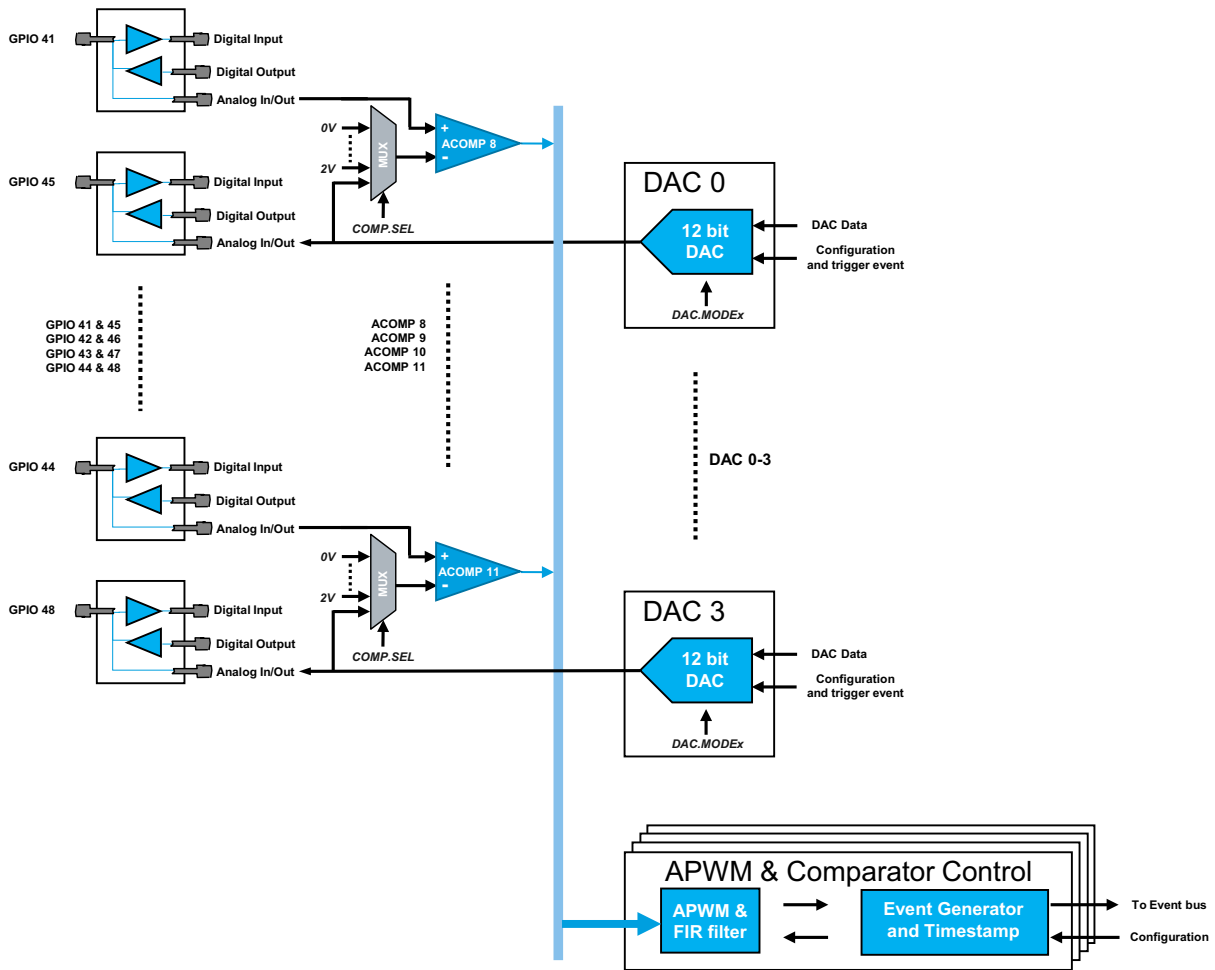
The supply ( $V_{DDA\_ADC}$  and  $V_{SSA\_ADC}$  for ADC0-2, and  $V_{DD\_IO}$  and GND for ADC3), needs to be well decoupled/filtered at high frequencies ( $>1\text{MHz}$ ) to not degrade the ADC performance. The ADC0-2 supply ground,  $V_{SSA\_ADC}$ , must always be directly connected to the same PCB ground point as  $V_{SSA\_REF}$ , close to these pins, to maintain ADC functionality and performance.

### 2.3.6 Internal DAC

There are four independent 12bit/3MSps internal DACs connected to external pins.

# LEON3FT Microcontroller

Figure 12. DAC connection to external pin and internal fast analog comparator



The DAC output is a sourcing-current single-ended output of 0 to 4mA, typically to be loaded by virtual ground generated by an op-amp on PCB, or by a passive impedance connected to PCB ground providing the output voltage directly across this impedance. These four DACs are supplied by  $V_{DDA\_DAC}$  and  $V_{SSA\_DAC}$ . Good decoupling of the supply is required at high frequencies (>1MHz).

### 2.3.7 Internal LDO

The LDO provides  $V_{DD\_CORE}$  with a regulated 1.8V, and needs a 3.3V input supply,  $V_{DD\_LDO}$ , see figure 9. The LDO can be by-passed, then the  $V_{DD\_CORE}$  pins are directly fed with 1.8V regulated supply voltage from PCB. In this case, the  $V_{DD\_LDO}$  pins must not be connected to any low-impedance node other than  $V_{DD\_CORE}$ . In any supply case, all  $V_{DD\_CORE}$  pins must be decoupled on PCB with a small capacitor, in the order of 10nF, directly at each  $V_{DD\_CORE}/GND$  pin pair.

The LDO will cause additional internal power dissipation: the core average current times the LDO voltage drop. It will further increase the junction temperature, which should be carefully checked especially when the LDO is in use at the same time as core current is high.

# LEON3FT Microcontroller

## 2.3.8 Temperature Sensor

There is a temperature sensor implemented on the GR716 microcontroller chip. Its output signal is a monotonic voltage versus temperature, and is measured by internal ADC0. Its output is not threshold detected or used in any other internal function, so if a chip over-temperature protection is desired, the user needs to measure the sensor and take adequate actions in the system application at hand, e.g., a digital trigger level can be programmed.

## 2.3.9 Core Supply Voltage Monitor

The core voltage,  $V_{DD\_CORE}$ , can be monitored via internal ADC1. The voltage measured can be used by the application to trim the core voltage when the internal LDO is in use. The default LDO trim value is maximum voltage, to always guarantee functionality in worst case corners at maximum supply current. For low power applications the core voltage can be decreased to optimum level in order to minimize power consumption.

## 2.3.10 Reference Output Voltage Monitor

The VREFBUF output voltage can be monitored via internal ADC2. It can be used as calibration measurement of VREFBUF in bridge measurements such as in the thermistor measurement example below.

## 2.3.11 PLL Supply Voltage Monitor

The PLL supply voltage,  $V_{DDA\_PLL}$ , can be monitored via internal ADC3. This supply voltage is generated by an internal LDO, and can be monitored for abnormal long-term drifts.

## 2.3.12 Fast analogue comparator

Fast analog comparators (ACOMP) are integrated into the analog IO of GR716B, and are connected to digital control and filter logic. Each analog comparator can be individually programmed with one input to a fixed-voltage trig level: 0, 0.125, 0.25, 0.5, 1.0, 1.5 or 2.0 [V]. Alternatively, both ACOMP inputs can be made available on package pins.

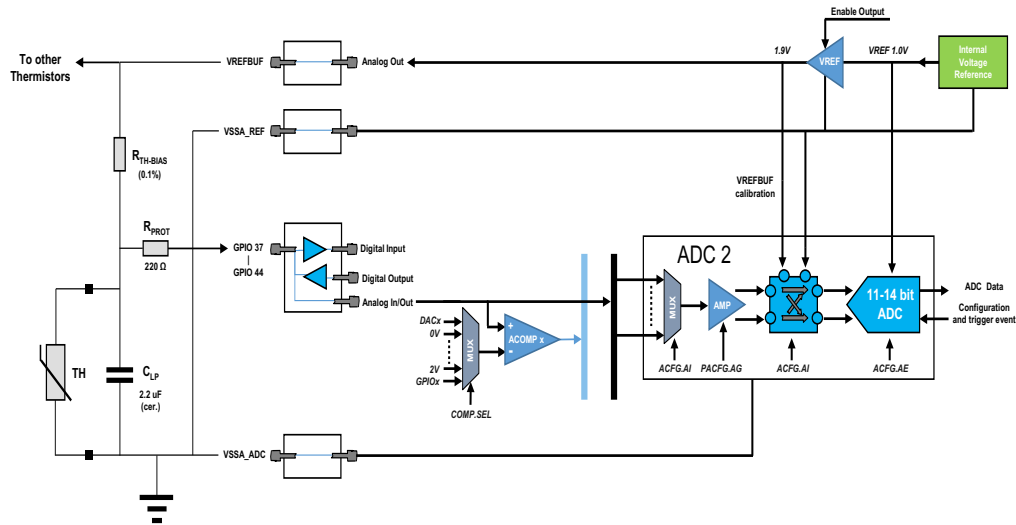
## 2.3.13 Precision reference output and thermistor bridge measurement

The precision reference voltage output, VREFBUF, can be enabled and used to facilitate applications such as thermistor measurements. The drive strength for VREFBUF output is 20mA sourcing current, which makes it suitable to drive many thermistors from one GR716B.

VREFBUF can be calibration measured by ADC2. Hence, if ADC2 is used to also measure the thermistor channel (any of GPIO 37-44), then these two measurements can give equivalent accuracy after software calculation as a bridge measurement provides, which considerably improves result accuracy.

# LEON3FT Microcontroller

Figure 13. Thermistor measurement based on bridge measurement by VREFBUF calibration



### 2.3.14 LVDS Common-mode, Cold-Spare and Fail-safe support

The extended common mode support makes GR716B suitable also for cable communication, and cold-spare function ensures LVDS transceiver high impedance when supply is tied to ground, or LVDS transmitter is disabled from software.

The LVDS receivers feature an internal fail-safe function, to ensure a known receiver state in case of input connection failure.

### 2.3.15 Analog test bus

There are separate analog test bus structures and test output buffers implemented in GR716B. Each individual test buffer can be made accessible via dedicated GPIO pins in analog test mode. The main purpose of the analog test bus is to measure and characterize the device in production. For more information contact [support@gaisler.com](mailto:support@gaisler.com).



# LEON3FT Microcontroller

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## 2.4 Signal Overview

The GR716 microcontroller has 64 external general purpose user input and outputs, 5 LVDS transmitters and 4 LVDS receivers and dedicated SPI memory interface. Almost all 64 external inputs and outputs and LVDS transceivers have multiple functionality. Functionality is selected by the application software during startup and configuration. During startup i.e. after reset all user input and outputs are configured as inputs.

## 2.5 I/O switch matrix overview

This section provides a introduction to the I/O switch matrix and gives a presentation to the pre-defined set of pin configuration.

The I/O switch matrix provides access to several I/O units. When an interface is not activated, its pins automatically become general purpose I/O. After reset, all I/O switch matrix pins are defined as inputs until programmed otherwise. Configuration and assigning of functions to external I/O is flexible and is controlled by software via registers described in section 7.1.

Table 7 shows a listing of all external CMOS pins in the I/O switch matrix and what functions can be assign to external pins. Table 7 also shows configuration registers to assign specific function or pin to external I/O. To assign a specific function or pin to an external interface the “column” value should be written into the table “row” I/O configuration register and bit field. E.g. register SYS.CFG.GP0.GP5 described in section 7.1.

Table 7. IO configuration matrix

REG	0x0	0x1	0x2	0x3	0x4	0x5	0x6	0x7	0x8	0x9	0xA	0xB	0xC	0xD	0xE	0xF
SYS.CFG.GP0	GP0	GPIO0 <sup>2)</sup>	UART_RTSN0	MEM_ADDR0	1553_RXENA	PWRX_BUSYN	CAN_TX0			SPIM_SLV1		SYNC_1	ALARM_0	tACOMP_PAS1		
	GP1	GPIO1 <sup>2)</sup>	UART_CTSN0	MEM_ADDR1	1553_TXA	PWRX_CLK	CAN_RX0			SPIM_SCK1		AB0_A	CF0_C	G_0		
	GP2	GPIO2 <sup>2)</sup>	UART_TX0	MEM_ADDR2	1553_RXA	PWRX_DATA	CAN_SEL0	I2CM_SDA0	SPIM_MOSII			AB0_B	CF0_D	G_1	tDAC_I_D0	
	GP3	GPIO3 <sup>2)</sup>	UART_RX0	MEM_ADDR3	1553_RXNA	PWRX_ABORT	CAN_RX1	I2CM_SCL0	SPIM_MISO1			AB1_A	CF0_E	G_2	tDAC_I_D1	
	GP4	GPIO4 <sup>2)</sup>	UART_CTSN1	MEM_ADDR4	1553_TXNA	PWRX_VALID	CAN_TX1	I2CM_SDA1	SPI_SCK0			AB1_B	CF0_F	G_3	tDAC_I_D2	
	GP5	GPIO5 <sup>2)</sup>	UART_RTSN1	MEM_ADDR5	1553_TXINHA	PWRX_RDY	CAN_SEL1	I2CM_SCL1	SPI_MISO0			A0_0	CF1_C	G*_0	tDAC_I_D3	
	GP6	GPIO6 <sup>2)</sup>	UART_TX1	MEM_ADDR6	1553_RXB	PWTX_VALID		I2CS_SDA0	SPI_MOSI0			A0_1	CF1_D	G*_1	tDAC_I_D4	
SYS.CFG.GP1	GP7	GPIO7 <sup>2)</sup>	UART_RX1	MEM_ADDR7	1553_RXNB	PWTX_CLK		I2CS_SCL0	SPI_SEL0			A0_2	CF1_E	G*_2	tDAC_I_D5	
	GP0	GPIO8 <sup>2)</sup>	UART_CTSN2	MEM_ADDR8	1553_RXENB	PWTX_BUSYN		I2CS_SDA1	SPI_SLV0_0			A0_3	CF1_F	G*_3	tDAC_I_D6	
	GP1	GPIO9 <sup>2)</sup>	UART_RTSN2	MEM_ADDR9	1553_TXB	PWTX_READY		I2CS_SCL1	SPI_SLV0_1		DAC0_CLK	CF2_C	G*_4	tDAC_I_D7		
	GP2	GPIO10 <sup>2)</sup>	UART_TX2	MEM_ADDR10	1553_CLK	PWTX_DATA		I2CS_SDA2	SPI_SLV0_2		DAC0_A	CF2_D	G*_5	tDAC_I_D8		
	GP3	GPIO11 <sup>2)</sup>	UART_RX2	MEM_ADDR11	1553_TXNB	PWTX_ABORT		I2CS_SCL2	SPI_SLV0_3		DAC0_B	CF2_E	G*_6	tDAC_I_D9		
	GP4	GPIO12 <sup>2)</sup>		MEM_ADDR12	1553_TXINHb						DAC0_C	CF2_F	G*_7	tDAC_I_D10		
	GP5	GPIO13 <sup>2)</sup>	UART_CTSN3	MEM_ADDR13			CAN_TX0		SPI_SCK1		DAC1_CLK	G_0	G*_8	tDAC_I_D011		
SYS.CFG.GP2	GP6	GPIO14 <sup>2)</sup>	UART_RTSN3	MEM_ADDR14		CAN_RX0		SPI_MISO1		DAC1_A	G_1	G*_9	tADC_O_D0			
	GP7	GPIO15 <sup>2)</sup>	UART_TX3	MEM_ADDR15		CAN_SEL0		SPI_MOSI1		DAC1_B	G_2	G*_10	tADC_O_D1			
	GP0	GPIO16 <sup>2)</sup>	UART_RX3	MEM_ADDR16		CAN_RX1		SPI_SEL1		DAC1_C	G_3	G*_11	tADC_O_D2			
	GP1	GPIO17 <sup>2)</sup>	UART_RTSN4	MEM_ADDR17				SPI_SLV1_0			ALARM_2	SYNC_0		tADC_O_D3		
	GP2	GPIO18 <sup>2)</sup>	UART_TX4	MEM_ADDR18			CAN_SEL1		SPI_SLV1_1		AB2_A	G*_0	CF0_C	tADC_O_D4		
	GP3	GPIO19 <sup>2)</sup>	UART_RX4	RAM_CSN0							AB2_B	G*_1	CF0_D	tADC_O_D5	TDP_SETET	tPLL_LOCK <sup>5)</sup>
	GP4	GPIO20 <sup>2)</sup>	UART_CTSN4	RAM_CSN1							AB3_A	G*_2	CF0_E	tADC_O_D6	TDP_E_ET_I	tSCRUB_CLK <sup>5)</sup>
SYS.CFG.GP3	GP5	GPIO21 <sup>2)</sup>	UART_RTSN5	RAM_CSN2				SPI_SLV1_2		AB3_B	G*_3	CF0_F	tADC_O_D7		tMIL_CLK <sup>5)</sup>	
	GP6	GPIO22 <sup>2)</sup>	UART_TX5	RAM_CSN3				SPI_SLV1_3		DAC2_CLK	G*_4	CF1_C	tADC_O_D8		tSPW_CLK <sup>5)</sup>	
	GP7	GPIO23 <sup>2)</sup>	UART_RX5	ROM_CSN0						DAC2_A	G*_5	CF1_D	tADC_O_D9		tSYS_CLK <sup>5)</sup>	
	GP0	GPIO24 <sup>2)</sup>	UART_TX5	ROM_CSN1						DAC2_B	G*_6	CF1_E	tADC_O_D10			
	GP1	GPIO25 <sup>2)</sup>		MEM_DATA0			PWRX_VALID	I2CM_SDA0	SPI_SCK0		DAC2_C	G*_7	CF1_F	tADC_O_EOC		SCRUB_INITN
	GP2	GPIO26 <sup>2)</sup>		MEM_DATA1			PWRX_CLK	I2CM_SCL0	SPI_MISO0		DAC3_CLK	G*_8	CF2_C	tADC_O_CMP		SCRUB_DONE
	GP3	GPIO27 <sup>2)</sup>		MEM_DATA2			PWRX_DATA	I2CM_SDA1	SPI_MOSI0		DAC3_A	G*_9	CF2_D	tBO_O		SCRUB_DATA0
SYS.CFG.GP4	GP4	GPIO28 <sup>2)</sup>		MEM_DATA3		PWRX_ABORT	I2CM_SCL1	SPI_SEL0		DAC3_B	G*_10	CF2_E	CLKDET_OK		SCRUB_DATA1	
	GP5	GPIO29 <sup>2)</sup>		MEM_DATA4		PWRX_BUSYN	I2CS_SDA0	SPI_SLV0_0		DAC3_C	G*_11	CF2_F	CLKDET_R00		SCRUB_DATA2	RINGOSC0
	GP6	GPIO30 <sup>2)</sup>		MEM_DATA5		PWRX_RDY	I2CS_SCL0	SPI_SLV0_1		ALARM_2	SYNC_0	AB0_A	CLKDET_E0		SCRUB_DATA3	
	GP7	GPIO31 <sup>2)</sup>		MEM_DATA6		PWTX_VALID	I2CS_SDA1	SPI_SLV0_2		SYNC_1	ALARM_0	AB0_B	CLKDET_RO1		SCRUB_DATA4	RINGOSC1
	GP0	GPIO32 <sup>2)</sup>		MEM_DATA7		PWTX_CLK	I2CS_SCL1	SPI_SLV0_3		A0_0	ALARM_1	SYNC_1	CLKDET_E1		SCRUB_DATA5	
	GP1	GPIO33 <sup>2)</sup>	UART_CTSN3	MEM_OEN		PWTX_BUSYN		I2CM_SDA0		A0_1	DAC0_CLK	AB1_A	LVDS_FSRX		SCRUB_DATA6	
	GP2	GPIO34 <sup>2)</sup>	UART_RTSN3	MEM_WRN		PWTX_READY		I2CM_SCL0		A0_2	DAC0_A	AB1_B			SCRUB_DATA7	
SYS.CFG.GP5	GP3	GPIO35 <sup>2)</sup>	UART_TX3	ROM_CSN0		PWTX_DATA	I2CS_SDA0		A0_3	DAC0_B	MEM_BRDYN			SCRUB_PROG		
	GP4	GPIO36 <sup>2)</sup>	UART_RX3	ROM_CSN1		PWTX_ABORT	I2CS_SCL0		ALARM_3	DAC0_C	MEM_BEXCN			SCRUB_RDWR		
	GP5	GPIO37 <sup>4)</sup>	UART_RTSN4		1553_RXENA	PWRX_VALID	CAN_TX0		SPI_SLV0_3	ADC <sup>1)</sup>			tACOMP_SET0		SCRUB_CSIN	
	GP6	GPIO38 <sup>4)</sup>	UART_TX4		1553_TXA	PWRX_CLK	CAN_RX0		SPI_SLV0_2	ADC <sup>1)</sup>					SCRUB_SCLK	
	GP7	GPIO39 <sup>4)</sup>	UART_RX4		1553_RXA	PWRX_DATA	CAN_SEL0	I2CS_SDA1	SPI_SLV0_1	ADC <sup>1)</sup>						
	GP0	GPIO40 <sup>4)</sup>	UART_CTSN4		1553_RXNA	PWRX_ABORT		I2CS_SCL1	SPI_SLV0_0	ADC <sup>1)</sup>						
	GP1	GPIO41 <sup>4)</sup>	UART_RTSN5	RAM_CSN2		1553_TXNA	PWRX_BYN	CAN_TX0	I2CM_SDA0	ADC <sup>1)</sup>	AB0_LEB <sup>3)</sup>					
SYS.CFG.GP6	GP2	GPIO42 <sup>4)</sup>	UART_TX5	RAM_CSN3	1553_TXINHA	PWRX_RDY	CAN_RX0	I2CM_SCL0	ADC <sup>1)</sup>	AB1_LEB <sup>3)</sup>						
	GP3	GPIO43 <sup>4)</sup>	UART_RX5	ROM_CSN0	1553_RXB	PWTX_VALID	CAN_SEL0	I2CS_SDA0	ADC <sup>1)</sup>	AB2_LEB <sup>3)</sup>						
	GP4	GPIO44 <sup>4)</sup>	UART_RX5	ROM_CSN1	1553_RXNB	PWTX_CLK	CAN_RX1	I2CS_SCL0	ADC <sup>1)</sup>	AB3_LEB <sup>3)</sup>						
	GP5	GPIO45 <sup>4)</sup>	UART_RX0		1553_RXENB	PWTX_BUSYN	CAN_RX1		SPI_SLV1_1	DAC0						
	GP6	GPIO46 <sup>4)</sup>	UART_TX0		1553_TXB	PWTX_RDY			SPI_SLV1_0	DAC1					ETH_TX_CLK	
	GP7	GPIO47 <sup>4)</sup>	UART_CTSN0		1553_CLK	PWTX_DATA	CAN_TX1	I2CM_SDA1	SPI_SCK1	DAC2					ETH_RX_CLK	
	GP0	GPIO48 <sup>4)</sup>	UART_RTSN0		1553_TXNB	PWTX_ABORT	CAN_SEL1	I2CM_SCL1	SPI_MISO1	DAC3					ETH_MDIO	
SYS.CFG.GP9	GP1	GPIO49 <sup>2)</sup>	UART_CTSN0	MEM_ADDR19	1553_TXINHb							SPIM_SLV1	AHBUART_TX	TDP_SETET	ETH_INT	
	GP2	GPIO50 <sup>2)</sup>	UART_TX0	MEM_ADDR20				I2CS_SCL2	SPI_SEL1			SPIM_SCK1	AHBUART_RX	TDP_E_ET_I	ETH_RXD3	
	GP3	GPIO51 <sup>4)</sup>	UART_RX0	MEM_ADDR21	1553_RXENA				SPI_MOSI1	ADC <sup>1)</sup>	AB0_TEB <sup>3)</sup>		SPIM_MOSI1	TDP_PULSE0	ETH_RXD2	
	GP4	GPIO52 <sup>4)</sup>	UART_CTSN1	MEM_ADDR22	1553_TXA	PWRX_VALID		I2CM_SDA0	SPI_SEL1	ADC <sup>1)</sup>	AB1_TEB <sup>3)</sup>		SPIM_MISO1	TDP_PULSE1	ETH_RXD1	
	GP5	GPIO53 <sup>4)</sup>	UART_RTSN1		1553_RXA	PWRX_CLK		I2CM_SCL0	SPIS_SCK0	ADC <sup>1)</sup>	AB2_TEB <sup>3)</sup>		SP14S_SCK1		ETH_RXD0	
	GP6	GPIO54 <sup>4)</sup>	UART_TX1		1553_RXNA	PWRX_DATA		I2CM_SDA1	SPIS_MISO0	ADC <sup>1)</sup>	AB3_TEB <sup>3)</sup>		SP14S_MISO1		ETH_RXDV	
	GP7	GPIO55 <sup>4)</sup>	UART_RX1		1553_TXNA	PWRX_ABORT		I2CM_SCL1	SPIS_MOSI0	ADC <sup>1)</sup>		A0_LEB <sup>3)</sup>	SP14S_MOSI1	TIMER32_TICKGEN	ETH_RXER	

Table 7. IO configuration matrix

REG	0x0	0x1	0x2	0x3	0x4	0x5	0x6	0x7	0x8	0x9	0xA	0xB	0xC	0xD	0xE	0xF
SYS_CFG.GP7	GP0	GPIO56 <sup>4)</sup>	UART_CTSN2		1553_TXINHA	PWRX_BSYN	I2CS_SDA0	SPIS_SLV0	ADC <sup>1)</sup>		A1_LEB <sup>3)</sup>	SP14S_SLV1	EVENT_TRIG			ETH_COL
	GP1	GPIO57 <sup>4)</sup>	UART_RTSN2		1553_RXB	PWRX_RDY	I2CS_SCL0	SPI_SCK0	ADC <sup>1)</sup>		A2_LEB <sup>3)</sup>		DNCNT24			ETH_CRS
	GP2	GPIO58 <sup>4)</sup>	UART_TXN2		1553_RXNB	PWTX_VALID	CAN_TX0	I2CS_SDA1	SPI_MISO0	ADC <sup>1)</sup>	A3_LEB <sup>3)</sup>		DNCNT12			ETH_TXD3
	GP3	GPIO59 <sup>6)</sup>	UART_RXN2		1553_RXENB	PWTX_CLK	CAN_RX0	I2CS_SCL1	SPI_MOSI0				TIMER32	ACOMP_SET1		ETH_TXD2
	GP4	GPIO60 <sup>6)</sup>	UART_CTSN3		1553_TXB	PWTX_BSYN	CAN_SEL0	I2CS_SDA2	SPI_SEL0				TIMER27	TDP_PULSE2		ETH_TXD1
	GP5	GPIO61 <sup>6)</sup>	UART_RXN3		1553_CLK	PWTX_RDY	CAN_RX1	I2CS_SCL2	SPI_SLV0_0				TIMEALARM	TDP_PULSE3		ETH_TXD0
	GP6	GPIO62 <sup>6)</sup>	UART_TX3	ROM_CSN0		1553_TXNB	PWTX_DATA	CAN_TX1	SPI_SLV0_1				PARITYERR	TDP_PULSE4		ETH_TXEN
	GP7	GPIO63 <sup>2)</sup>	UART_RTSN3	ROM_CSN1	1553_TXINHB	PWTX_ABORT	CAN_SEL1		SPI_SLV0_2				APWM_OUT	TDP_PULSE5		ETH_TXER
SYS_CFG.LVDS0	LVDS TX0 <sup>10)</sup>	SPW_TXD0		SPI_SCK0 <sup>8)</sup>		LVDS_OUT0 <sup>7)</sup>			Disable							
	LVDS TX1 <sup>10)</sup>	SPW_TXS0		SPI_SEL0 <sup>8)</sup>		LVDS_OUT1 <sup>7)</sup>			Disable							
	LVDS TX2 <sup>10)</sup>		SP14S_MISO0	SPI_MOSI0 <sup>8)</sup>	SPI_MISO0 <sup>9)</sup>	LVDS_OUT2 <sup>7)</sup>			Disable							
	LVDS RX0 <sup>10)</sup>	SPW_RXD1	SP14S_CLK0	SPI_MISO0 <sup>8)</sup>	SPI_SCK0 <sup>9)</sup>	LVDS_IN0 <sup>7)</sup>			Disable							
	LVDS RX1 <sup>10)</sup>	SPW_RXD0	SP14S_MOSI0		SPI_MOSI0 <sup>9)</sup>	LVDS_IN1 <sup>7)</sup>			Disable							
	LVDS RX2 <sup>10)</sup>	SPW_RXS0	SP14S_SLV0		SPI_SEL0 <sup>9)</sup>	LVDS_IN2 <sup>7)</sup>			Disable							
	NA								Disable							
	LVDS RX3 <sup>10)</sup>	SPW_RXS1				LVDS_IN3 <sup>7)</sup>			Disable							
SYS_CFG.LVDS1	LVDS TX4 <sup>6) 10)</sup>	SPW_TXD1	SP14S_MISO0	SPI_MOSI0 <sup>8)</sup>	SPI_MISO0 <sup>9)</sup>	LVDS_OUT4 <sup>7)</sup>			Disable							
	LVDS TX5 <sup>6) 10)</sup>	SPW_TXS1				LVDS_OUT5 <sup>7)</sup>			Disable							
	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-

- Note 1: There are four independent ADC blocks.  
GPIO 37-44 are the 8 external MUX pins for ADC0, ADC1 and ADC2, i.e., the same 8 GPIO pins are internally connected to all three ADC MUXs in parallel.  
GPIO 51-58 are the 8 external MUX pins for ADC3.  
See Figure 10 and 11 for more details.
- Note 2: IO has programmable input Schmitt trigger mode
- Note 3: Analogue PWM Leading Edge Blanking (LEB) / Trailing Edge Blanking signal. Signal will drive 'Low' or 'HiZ'
- Note 4: IO is connected to an onchip analogue comparator

Comparator #	Pos GPIO #	Neg GPIO #
0	37	38
1	38	39
2	39	40
3	40	41
4	41	40
5	42	41
6	43	42
7	44	43
8	41	45
9	42	46
10	43	47
11	44	48

Comparator #	Pos GPIO #	Neg GPIO #
12	51	52
13	52	53
14	53	54
15	54	55
16	55	54
17	56	55
18	57	56
19	58	57

- Note 5: Internal PLL Lock and clocks driven out on GPIOs for test purposes
- Note 6: LVDS port available via GPIO port 59, 60, 61 and 62. When LVDS port is enabled using CFG.LVDS1.TX4 or CFG.LVDS1.TX5 then the respective GPIO is disabled. When GPIO is utilized then the corresponding registers CFG.LVDS1.TX4 or CFG.LVDS1.TX5 must not be enabled.
- Note 7: LVDS GPIO mode enables LVDS TX/RX to be used as general purpose inputs and outputs
- Note 8: SPI Master interface refer section 44 SPI Controller
- Note 9: SPI Slave interface refer section 44 SPI Controller
- Note 10: Refer section 58.2 for corresponding pin assignment.

# LEON3FT Microcontroller

## 2.6 I/O switch for APWM\_DAC output signals

This chapter lists external GPIO pins with special purpose when used for PWM DAC output applications.

Table 8. External APWM DAC pin configuration

Pin Name	Interface Name	PWMDAC #	Functional description
GPIO[9]	DAC0_CLK	0	External APWM DAC 0 pins. Pins needs external filter to function. See figure 14 and 15 for single or combined PWM DAC output examples
GPIO[10]	DAC0_A	0	
GPIO[11]	DAC0_B	0	
GPIO[12]	DAC0_C	0	
GPIO[13]	DAC1_CLK	1	External APWM DAC 1 pins. Pins needs external filter to function. See figure 14 and 15 for single or combined PWM DAC output examples
GPIO[14]	DAC1_A	1	
GPIO[15]	DAC1_B	1	
GPIO[16]	DAC1_C	1	
GPIO[22]	DAC2_CLK	2	External APWM DAC 2 pins. Pins needs external filter to function. See figure 14 and 15 for single or combined PWM DAC output examples
GPIO[23]	DAC2_A	2	
GPIO[24]	DAC2_B	2	
GPIO[25]	DAC2_C	2	
GPIO[26]	DAC3_CLK	3	External APWM DAC 3 pins. Pins needs external filter to function. See figure 14 and 15 for single or combined PWM DAC output examples
GPIO[27]	DAC3_A	3	
GPIO[28]	DAC3_B	3	
GPIO[29]	DAC3_C	3	

Note 1: TBD

Figure 14. Single output PWM DAC filter.

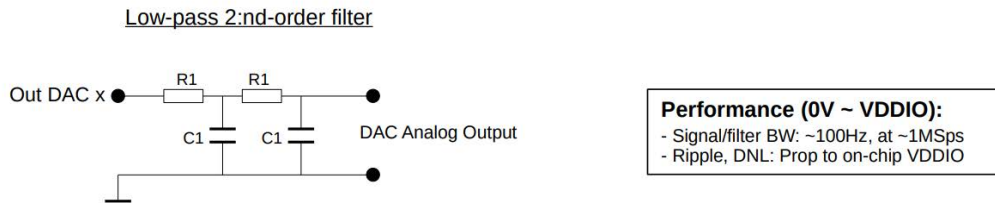
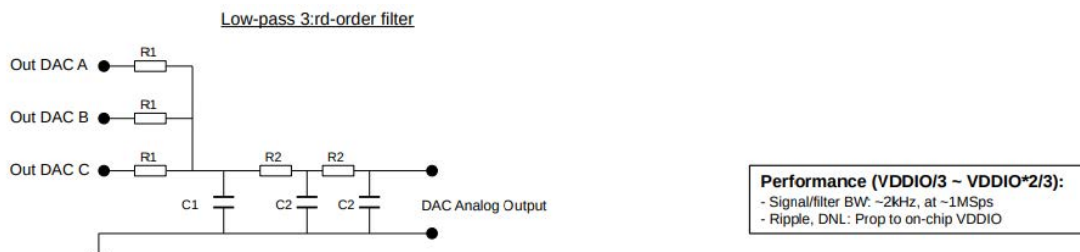


Figure 15. Combined output PWM DAC filter.



# LEON3FT Microcontroller

## 2.7 I/O switch default configurations for bootstraps

This chapter lists external pin connection for all valid boot strap options.

### 2.7.1 External pin configuration for SpaceWire remote access

This section describes valid bootstrap configuration for SpaceWire remote access.

Table 9. Remote SpaceWire pin configurations

Pin Name	Interface Name	Functional description
LVDS_RX[1]	SPW_RXD0	SpaceWire receiver data interface
LVDS_RX[2]	SPW_RXS0	SpaceWire receiver strobe interface
LVDS_TX[0]	SPW_TXD0	SpaceWire transmitter data interface
LVDS_TX[1]	SPW_TXS0	SpaceWire transmitter strobe interface
LVDS_RX[0]	SPW_RXD1	SpaceWire receiver data interface
LVDS_RX[3]	SPW_RXS1	SpaceWire receiver strobe interface
LVDS_TX[4] <sup>2)</sup>	SPW_TXD1	SpaceWire transmitter data interface
LVDS_TX[5] <sup>2)</sup>	SPW_TXS1	SpaceWire transmitter strobe interface

Note 1: Remote SpaceWire interface uses LVDS type interface

Note 2: Available vi GPIO Mux

### 2.7.2 External pin configuration for UART remote access

This section describes valid bootstrap configuration for UART remote access. Refer to section 48 for details on the communication protocol.

Table 10. Remote UART access pin configurations

Pin Name	Interface Name	Functional description
GPIO[49]	AHBUART_TX	UART transmitter interface
GPIO[50]	AHBUART_RX	UART receiver interface

Note 1: Interface uses CMOS type interface

### 2.7.3 External pin configuration for I2C remote access

This section describes valid bootstrap configuration for I2C remote access. Refer to section 39 for details on the communication protocol.

Table 11. Remote I2C access pin configurations

Pin Name	Interface Name	Functional description
GPIO[49]	I2C_SDA	I2C Serial Data interface
GPIO[50]	I2C_SCL	I2C Serial Clock interface

Note 1: Interface uses CMOS type interface

Note 2: I2C address should be set using external boot strap pin number 15, 62 and 0

# LEON3FT Microcontroller

## 2.7.4 External pin configuration for SPI remote access

This section describes valid bootstrap configuration for SPI remote access. Refer to section 43 for details on the communication protocol.

Table 12. Remote SPI access pin configurations

Pin Name	Interface Name	Functional description
GPIO[53]	SPIS_SCK	SPI Slave Clock interface
GPIO[54]	SPIS_MISO	SPI Master input Slave output interface
GPIO[55]	SPIS_MOSI	SPI Master output Slave input interface
GPIO[56]	SPIS_SLV	SPI Slave Select interface

Note 1: Interface uses CMOS type interface

## 2.7.5 External pin configuration for CAN-FD (CANOpen) remote access

This section describes valid bootstrap configuration for CAN-FD remote access. Refer to section 26 for details on the communication protocol.

Table 13. Remote SPI access pin configurations

Pin Name	Interface Name	Functional description
GPIO[58]	CAN_TX0	CAN-FD Transmitter 0 output
GPIO[59]	CAN_RX0	CAN-FD Reciever 0 input
GPIO[60]	CAN_SEL0	CAN-FD Output 0 select
GPIO[61]	CAN_TX1	CAN-FD Transmitter 1 output
GPIO[62]	CAN_RX1	CAN-FD Reciever 1 input
GPIO[63]	CAN_SEL1	CAN-FD Output 1 select

Note 1: Interface uses CMOS type interface

Note 2: CAN FD (CANOpen) parameters must be configured: (TBD)

## 2.7.6 External pin configuration for external SPI boot memory

This section describes valid bootstrap configuration for external SPI memory. Refer to section 46 for a detailed description of the SPI memory controllers.

Table 14. SPI memory pin configurations

Pin Name	Interface Name	Functional description
SPIM_MOSI	SPIM_MOSI	SPI Memory master output slave input
SPIM_SCK	SPIM_SCK	SPI Memory master clock output
SPIM_SEL	SPIM_SEL	SPI Memory slave select output
SPIM_MISO	SPIM_MISO	SPI Memory master input slave output
GPIO[2]	SPIM_MOSI1	Redundant SPI Memory master output slave input
GPIO[1]	SPIM_SCK1	Redundant SPI Memory master clock output
GPIO[0]	SPIM_SEL1	Redundant SPI Memory slave select output
GPIO[3]	SPIM_MISO1	Redundant SPI Memory master input slave output

Note 1: Interface uses CMOS type interface

# LEON3FT Microcontroller

## 2.7.7 External pin configuration for external SRAM boot memory

This section describes valid bootstrap configuration for external SRAM. Refer to chapter 22 for a detailed description of the SRAM memory controller.

Table 15. SRAM memory pin configurations

Pin Name	Interface Name	Functional description
GPIO[0]	MEM_ADDR[0]	Memory address interface
GPIO[1]	MEM_ADDR[1]	
GPIO[2]	MEM_ADDR[2]	
GPIO[3]	MEM_ADDR[3]	
GPIO[4]	MEM_ADDR[4]	
GPIO[5]	MEM_ADDR[5]	
GPIO[6]	MEM_ADDR[6]	
GPIO[7]	MEM_ADDR[7]	
GPIO[8]	MEM_ADDR[8]	
GPIO[9]	MEM_ADDR[9]	
GPIO[10]	MEM_ADDR[10]	
GPIO[11]	MEM_ADDR[11]	
GPIO[12]	MEM_ADDR[12]	
GPIO[13]	MEM_ADDR[13]	
GPIO[14]	MEM_ADDR[14]	
GPIO[15]	MEM_ADDR[15]	
GPIO[16]	MEM_ADDR[16]	
GPIO[17]	MEM_ADDR[17]	
GPIO[18]	MEM_ADDR[18]	
GPIO[33]	MEM_OEN	Output interface
GPIO[34]	MEM_WRN	Written enable interface
GPIO[25]	MEM_DATA[0]	Data interface
GPIO[26]	MEM_DATA[1]	
GPIO[27]	MEM_DATA[2]	
GPIO[28]	MEM_DATA[3]	
GPIO[29]	MEM_DATA[4]	
GPIO[30]	MEM_DATA[5]	
GPIO[31]	MEM_DATA[6]	
GPIO[32]	MEM_DATA[7]	
GPIO[19]	RAM_CSN[0]	Chip Select
GPIO[20]	RAM_CSN[1]	Redundant Chip Select

Note 1: Interface uses CMOS type interface

Note 2: MEM\_ADDR[22:19] remain configured as GPIO. It is recommended to have pull-down resistors to ground on interface address pins higher than interface pin MEM\_ADDR[18].

# LEON3FT Microcontroller

## 2.7.8 External pin configuration for external PROM/FLASH boot memory

This section describes valid bootstrap configuration for external PROM/FLASH. Refer to chapter 22 for a detailed description of the PROM/FLASH memory controller.

Table 16. PROM/FLASH memory pin configurations

Pin Name	Interface Name	Functional description
GPIO[0]	MEM_ADDR[0]	Memory address interface
GPIO[1]	MEM_ADDR[1]	
GPIO[2]	MEM_ADDR[2]	
GPIO[3]	MEM_ADDR[3]	
GPIO[4]	MEM_ADDR[4]	
GPIO[5]	MEM_ADDR[5]	
GPIO[6]	MEM_ADDR[6]	
GPIO[7]	MEM_ADDR[7]	
GPIO[8]	MEM_ADDR[8]	
GPIO[9]	MEM_ADDR[9]	
GPIO[10]	MEM_ADDR[10]	
GPIO[11]	MEM_ADDR[11]	
GPIO[12]	MEM_ADDR[12]	
GPIO[13]	MEM_ADDR[13]	
GPIO[14]	MEM_ADDR[14]	
GPIO[15]	MEM_ADDR[15]	
GPIO[16]	MEM_ADDR[16]	
GPIO[17]	MEM_ADDR[17]	
GPIO[18]	MEM_ADDR[18]	
GPIO[33]	MEM_OEN	Output interface
GPIO[34]	MEM_WRN	Written enable interface
GPIO[25]	MEM_DATA[0]	Data interface
GPIO[26]	MEM_DATA[1]	
GPIO[27]	MEM_DATA[2]	
GPIO[28]	MEM_DATA[3]	
GPIO[29]	MEM_DATA[4]	
GPIO[30]	MEM_DATA[5]	
GPIO[31]	MEM_DATA[6]	
GPIO[32]	MEM_DATA[7]	
GPIO[35]	ROM_CSN[0]	Chip Select
GPIO[36]	ROM_CSN[1]	Redundant Chip Select

Note 1: Interface uses CMOS type interface

Note 2: MEM\_ADDR[22:19] remain configured as GPIO. It is recommended to have pull-down resistors to ground no interface address pins higher than interface pin MEM\_ADDR[18].



# LEON3FT Microcontroller

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## 2.8 I/O switch matrix options, considerations and limitations

This chapter lists options and limitations when using different interfaces in the IO switch.

### 2.8.1 SPI interfaces

The SPI interface can switch from being a Master to Slave interface and vice versa. In general this is not a problem and adds flexibility to the I/O mux concept except for the 'slave select' signal. The 'slave select' signal will change direction when switching from Slave i.e. slave select input signal to Master interface i.e. slave select output. In the worst scenario this can permanently damage the internal driver and receiver. To mitigate this problem the Master Slave select output and Slave Select input has been assigned to different I/Os.

In a situation where the application board only requires the SPI interface to either be Slave or Master the option is given to the designer to assign the extra pin to another system interface.

### 2.8.2 External Memory interface

The external PROM/SRAM interface occupies many external I/Os due parallel data and address buses. The system should only allocate the number of address and chip-select pins needed for the application. E.g. a system that only requires 256KiB of memory only need to allocate and use 18 external address lines and 1 chip-select i.e. the system can assign 4 pins to another system interface.

There is also a potential saving to make if the functionality 'bus ready' and 'bus exception' isn't used.

# LEON3FT Microcontroller

## 2.9 Cores

The design is based on the following cores from the GRLIB IP Library:

Table 17. Used IP cores

Core	Function	Vendor	Device
AHB2AHB	Bi-directional AHB/AHB bridge	0x01	0x020
AHBROM	Generic AHB ROM	0x01	0x1B
AHBSTAT	AHB Status Register	0x01	0x052
AHBTRACE	AHB trace buffer	0x01	0x017
AHBUART	Serial/AHB Debug interface	0x01	0x007
APBCTRL	AHB/APB bridge	0x01	0x006
APBUART	8-bit UART with FIFO	0x01	0x00C
DSU3	LEON3 Debug Support Unit	0x01	0x004
FTMCTRL	8/16/32-bit memory controller with EDAC	0x01	0x054
GPTIMER	Modular timer unit with watchdog	0x01	0x038
GR1553B	MIL-STD-1553B / AS15531 interface	0x01	0x04D
GRAPWM	Analog PWM system	0x01	n/a
GRCANFD	CAN Flexible Data Rate Controller	0x01	0x0B5
GRCLKGATE	Clock gating unit	0x01	0x02C
GRDMAC2	DMA Controller with internal AHB/APB bridge	0x01	0x0C0
GRETH	10/100 Ethernet Media Access Controller (MAC)	0x01	0x01D
GRGPIO	General Purpose I/O Port	0x01	0x01A
GRGPREG	General purpose register	0x01	0x087
GRMEMPROT	Memory protection	0x01	0x1F1
GRPWRX	PacketWire receiver	0x01	0x08D
GRPWTX	PacketWire transmitter	0x01	0x08E
GRSPWROUTER	SpaceWire Router switch	0x01	0x03E
I2C2AHB	I2C to AHB bridge	0x01	0x00B
I2CMST	I2C master	0x01	0x028
I2CSLV	I2C slave	0x01	0x03E
IRQ(A)MP	Multiprocessor interrupt controller with AMP extensions	0x01	0x00D
L3STAT	LEON3 statistical unit	0x01	0x098
LEON3FT	LEON3 SPARC V8 32-bit processor	0x01	0x053
LRAM	Local on-chip SRAM with EDAC and AHB interface	0x01	0x0A3
MEMSCRUB	Memory scrubber	0x01	0x057
RSTGEN	Reset generator	N/A	N/A
RTA	Real-Time Accelerator subsystem	0x01	n/a
SPI2AHB	SPI to AHB bridge	0x01	0x05C
SPICTRL	SPI controller	0x01	0x02D
SPIMCTRL	SPI memory controller	0x01	0x045
SPISLAVE	SPI for space slave	0x01	0x0A7

The information in the last two columns is available via plug'n'play information in the system and is used by software to detect peripherals and to initialize software drivers.

# LEON3FT Microcontroller

## 2.10 Memory map

The memory map of the internal AHB and APB buses as seen from the processor cores can be seen below.

The column 'DMA Access' in the Memory map table indicates if the AMBA peripheral is accessible by a DMA controller.

Table 18. AMBA memory map, as seen from processors

Core	Address range	Area	RTA Access	
AHBROM	0x00000000 - 0x000FFFFFFF	Internal Boot PROM	No	
FTMCTRL	0x01000000 - 0x01FFFFFFF	External PROM	No	
SPIMCTRL0	0x02000000 - 0x03FFFFFFF	SPI Memory 0 mapped 3-byte address area	No	
SPIMCTRL1	0x04000000 - 0x05FFFFFFF	SPI Memory 1 mapped 3-byte address area	No	
SPIMCTRL0	0x10000000 - 0x17FFFFFFF	SPI Memory 0 mapped 4-byte address area	No	
SPIMCTRL1	0x18000000 - 0x1FFFFFFF	SPI Memory 1 mapped 4-byte address area	No	
DLRAM	0x30000000 - 0x30FFFFFFF	Processor local data memory	No	
ILRAM	0x31000000 - 0x31FFFFFFF	Processor local instruction memory	No	
FTMCTRL	0x40000000 - 0x4FFFFFFF	External SRAM Memory	No	
NVRAM	0x50000000 - 0x50FFFFFFF	Reserved space for internal NVRAM	No	
RTA 0	DLRAM	0x60000000 - 0x60000FFF	Local RTA data memory	Yes
	ILRAM	0x61000000 - 0x61000FFF	Local RTA instruction memory	Yes
	IRQMP	0x62000000 - 0x620000FF	Local interrupt controller	Yes
	GPTIMER	0x62010000 - 0x620100FF	Local Watchdog timer and timer unit	Yes
	ILRAM CFG	0x62020000 - 0x620200FF	Local instruction memory configuration	Yes
	DLRAM CFG	0x62030000 - 0x620300FF	Local data memory configuration	Yes
	STAT	0x62040000 - 0x620400FF	RTA Status and mailbox register	Yes
	GPREG	0x62050000 - 0x620500FF	RTA Configuration register	Yes
	RTM	0x62060000 - 0x620600FF	RTA Task Manager 0	Yes
	RTM	0x62070000 - 0x620700FF	RTA Task Manager 1	Yes
	RTM	0x62080000 - 0x620800FF	RTA Task Manager 2	Yes
	AHBSTAT	0x62090000 - 0x620900FF	RTA AHB Status Register for local bus	Yes
RTA 1	DLRAM	0x70000000 - 0x70000FFF	Local RTA data memory	Yes
	ILRAM	0x71000000 - 0x71000FFF	Local RTA instruction memory	Yes
	IRQMP	0x72000000 - 0x720000FF	Local interrupt controller	Yes
	GPTIMER	0x72010000 - 0x720100FF	Local Watchdog timer and timer unit	Yes
	ILRAM CFG	0x72020000 - 0x720200FF	Local instruction memory configuration	Yes
	DLRAM CFG	0x72030000 - 0x720300FF	Local data memory configuration	Yes
	STAT	0x72040000 - 0x720400FF	RTA Status and mailbox register	Yes
	GPREG	0x72050000 - 0x720500FF	RTA Configuration register	Yes
	RTM	0x72060000 - 0x720600FF	RTA Task Manager 0	Yes
	RTM	0x72070000 - 0x720700FF	RTA Task Manager 1	Yes
	RTM	0x72080000 - 0x720800FF	RTA Task Manager 2	Yes
	AHBSTAT	0x72090000 - 0x720900FF	RTA AHB Status Register for local bus	Yes

# LEON3FT Microcontroller

Table 18. AMBA memory map, as seen from processors

Core	Address range	Area	RTA Access	
A P B B C T R L 0	FTMCTRL	0x80000000 - 0x800000FF	Memory controller with EDAC	No
	DLRAM	0x80001000 - 0x800010FF	On-chip Data memory control registers	No
	IRQAMP	0x80002000 - 0x800023FF	Multi-processor Interrupt Ctrl.	No
	GPTIMER	0x80003000 - 0x800030FF	Modular Timer Unit 0 with Watchdog support	No
	GPTIMER	0x80004000 - 0x800040FF	Modular Timer Unit 1	No
	MEMPROT	0x80005000 - 0x800051FF	Memory Protection Unit for system bus	No
	GRCLKGATE	0x80006000 - 0x800060FF	Clock gating configuration register unit 0	No
	GRCLKGATE	0x80007000 - 0x800070FF	Clock gating configuration register unit 1	No
	GRGPREG	0x80008000 - 0x800080FF	Configuration and test registers	No
	L3STAT	0x80009000 - 0x800093FF	LEON3 Statistics Unit	No
	AHBSTAT	0x8000A000 - 0x8000A0FF	AHB Status Register for DMA AMBA bus	No
	ILRAM	0x8000B000 - 0x8000B0FF	On-chip Instruction memory control registers	No
	GRSPWTDTP	0x8000C000 - 0x8000C1FF	CCSDS TDP / SpaceWire I/F	No
	GRGPRBANK	0x8000D000 - 0x8000D0FF	IO Mux configuration register	No
A P B C T R L 1	GRGPREG	0x8000E000 - 0x8000E0FF	Test register and system control register	No
	AHBUART	0x8000F000 - 0x8000F0FF	Slave UART configuration for remote access	No
	GRSPWROUTER	0x80100000 - 0x801000FF	GRSPWROUTER SpaceWire Router	No
	GR1553B	0x80101000 - 0x801010FF	MIL-STD-1553B Interface	No
	GRCANFD	0x80102000 - 0x801023FF	CANFD Controller with DMA	No
	Not used	0x80103000 - 0x801033FF	-	No
	SPI2AHB	0x80104000 - 0x801040FF	SPI to AHB Bridge	No
	I2C2AHB	0x80105000 - 0x801050FF	I2C to AHB Bridge	No
	GRDMAC	0x80106000 - 0x801061FF	Stand alone DMA unit 0	No
	GRDMAC	0x80107000 - 0x801071FF	Stand alone DMA unit 1	No
	GRGPRBANK	0x80108000 - 0x801081FF	LVDS IO configuration registers	No
	GRETH	0x80109000 - 0x801091FF	GRETH 10/100 Ethernet MAC with AHB	No
	MEMPROT	0x8010A000 - 0x8010A0FF	Memory protection for DMA bus	No
	PLL	0x8010B000 - 0x8010B0FF	System clock control register	No
	BO	0x8010C000 - 0x8010C0FF	Brown-Out detection control registers	No
	PLL	0x8010D000 - 0x8010D0FF	PLL control registers	No
	PWRX	0x8010E000 - 0x8010E0FF	PacketWire Receiver with DMA	No
PWTX	0x8010F000 - 0x8010F0FF	PacketWire Transmitter with DMA	No	

# LEON3FT Microcontroller

Table 18. AMBA memory map, as seen from processors

Core		Address range	Area	RTA Access
A P B C T R L 2	APBUART	0x80300000 - 0x803000FF	Generic UART 0	Yes
	APBUART	0x80301000 - 0x803010FF	Generic UART 1	Yes
	APBUART	0x80302000 - 0x803020FF	Generic UART 2	Yes
	APBUART	0x80303000 - 0x803030FF	Generic UART 3	Yes
	APBUART	0x80304000 - 0x803040FF	Generic UART 4	Yes
	APBUART	0x80305000 - 0x803050FF	Generic UART 5	Yes
	AHBSTAT	0x80306000 - 0x803060FF	AHB Status Register for MAIN AMBA bus	Yes
	NVRAM	0x80307000 - 0x803070FF	Memory controller with EDAC (NVRAM)	Yes
	-	0x80308000 - 0x803080FF	Unused	-
	SPICTRL	0x80309000 - 0x803090FF	SPI Controller 0	Yes
	SPICTRL	0x8030A000 - 0x8030A0FF	SPI Controller 1	Yes
	LVDS GPIO	0x8030B000 - 0x8030BFFF	LVDS GPIO Mode Control	Yes
	GRGPIO	0x8030C000 - 0x8030CFFF	General Purpose I/O port 0 to 31	Yes
	GRGPIO	0x8030D000 - 0x8030DFFF	General Purpose I/O port 32 to 64	Yes
A P B C T R L 3	I2CMST	0x8030E000 - 0x8030E0FF	I2C-master 0	Yes
	I2CMST	0x8030F000 - 0x8030F0FF	I2C-master 1	Yes
	ADC	0x80400000 - 0x804000FF	On-chip ADC interface 0	Yes
	ADC	0x80401000 - 0x804010FF	On-chip ADC interface 1	Yes
	ADC	0x80402000 - 0x804020FF	On-chip ADC interface 2	Yes
	ADC	0x80403000 - 0x804030FF	On-chip ADC interface 3	Yes
	SCRUBBER	0x80404000 - 0x804040FF	FPGA Scrubber	Yes
	-	0x80405000 - 0x804050FF	Unused	-
	-	0x80406000 - 0x804060FF	Unused	-
	-	0x80407000 - 0x804070FF	Unused	-
	DAC	0x80408000 - 0x804080FF	On-chip DAC interface 0	Yes
	DAC	0x80409000 - 0x804090FF	On-chip DAC interface 1	Yes
	DAC	0x8040A000 - 0x8040A0FF	On-chip DAC interface 2	Yes
	DAC	0x8040B000 - 0x8040B0FF	On-chip DAC interface 3	Yes
I2CSLV	0x8040C000 - 0x8040C0FF	I2C-slave 0	Yes	
I2CSLV	0x8040D000 - 0x8040D0FF	I2C-slave 1	Yes	
GRSPI4	0x8040F000 - 0x8040F0FF	SPI for Space Slave	Yes	

# LEON3FT Microcontroller

Table 18. AMBA memory map, as seen from processors

Core	Address range	Area	RTA Access	
A P B C T R L 4	TIMER32	0x81000000 - 0x810000FF	APWM system timer and synchronization	Yes
	TIMER32	0x81001000 - 0x810010FF	APWM system timer and synchronization	Yes
	REGSYNC	0x81002000 - 0x810020FF	APWM Register synchronization	Yes
	PROTSHDN	0x81003000 - 0x810030FF	Protection shutdown A	Yes
	PROTSHDN	0x81004000 - 0x810040FF	Protection shutdown B	Yes
	PROTSHDN	0x81005000 - 0x810050FF	Protection shutdown C	Yes
	SYNC	0x81006000 - 0x810060FF	External synchronization	Yes
	COMP	0x81007000 - 0x810070FF	Analog comparator A	Yes
	COMP	0x81008000 - 0x810080FF	Analog comparator B	Yes
	APWMDAC	0x81009000 - 0x810090FF	PWM modulator DAC A	Yes
	APWMDAC	0x8100A000 - 0x8100A0FF	PWM modulator DAC B	Yes
	APWMDAC	0x8100B000 - 0x8100B0FF	PWM modulator DAC C	Yes
	APWMDAC	0x8100C000 - 0x8100C0FF	PWM modulator DAC D	Yes
	CLKDET	0x8100D000 - 0x8100D0FF	Clock error detection 0	Yes
TIMER27	0x8100E000 - 0x8100E0FF	APWM function timer and synchronization	Yes	
TIMER27	0x8100F000 - 0x8100F0FF	APWM function timer and synchronization	Yes	
A P B C T R L 5	REGSYNCA	0x81100000 - 0x811000FF	APWM A0 Timer and synchronization	Yes
	APWMA	0x81101000 - 0x811010FF	APWM A0 0	Yes
	APWMA	0x81102000 - 0x811020FF	APWM A0 1	Yes
	APWMA	0x81103000 - 0x811030FF	APWM A0 2	Yes
	APWMA	0x81104000 - 0x811040FF	APWM A0 3	Yes
	Not used	0x81105000 - 0x811050FF	-	Yes
	Not used	0x81106000 - 0x811060FF	-	Yes
	Not used	0x81107000 - 0x811070FF	-	Yes
	Not used	0x81108000 - 0x811080FF	-	Yes
	Not used	0x81109000 - 0x811090FF	-	Yes
	FIRCLKGEN	0x8110A000 - 0x8110A0FF	FIR filter clock and synchronization	Yes
	CLOCKDET	0x8110B000 - 0x8110B0FF	Clock error detection 1	Yes
	TIMESTAMP	0x8110C000 - 0x8110C0FF	APWM Timestamp	Yes
	Not used	0x8110D000 - 0x8110D0FF	-	Yes
Not used	0x8110E000 - 0x8110E0FF	-	Yes	
Not used	0x8110F000 - 0x8110F0FF	-	Yes	

# LEON3FT Microcontroller

Table 18. AMBA memory map, as seen from processors

Core	Address range	Area	RTA Access	
A P B C T R L 6	REGSYNCAB	0x81200000 - 0x812000FF	APWM AB0 Timer and synchronization	Yes
	APWMAB	0x81201000 - 0x812010FF	APWM AB0	Yes
	REGSYNCAB	0x81202000 - 0x812020FF	APWM AB1 Timer and synchronization	Yes
	APWMAB	0x81203000 - 0x812030FF	APWM AB1	Yes
	REGSYNCAB	0x81204000 - 0x812040FF	APWM AB2 Timer and synchronization	Yes
	APWMAB	0x81205000 - 0x812050FF	APWM AB2	Yes
	REGSYNCAB	0x81206000 - 0x812060FF	APWM AB3 Timer and synchronization	Yes
	APWMAB0	0x81207000 - 0x812070FF	APWM AB3	Yes
	FIR	0x81208000 - 0x812080FF	APWM FIR filter 0	Yes
	FIR	0x81209000 - 0x812090FF	APWM FIR filter 1	Yes
	FIR	0x8120A000 - 0x8120A0FF	APWM FIR filter 2	Yes
	FIR	0x8120B000 - 0x8120B0FF	APWM FIR filter 3	Yes
	FIR	0x8120C000 - 0x8120C0FF	APWM FIR filter 4	Yes
	FIR	0x8120D000 - 0x8120D0FF	APWM FIR filter 5	Yes
	FIR	0x8120E000 - 0x8120E0FF	APWM FIR filter 6	Yes
	FIR	0x8120F000 - 0x8120F0FF	APWM FIR filter 7	Yes
A P B C T R L 7	REGSYNCCF	0x81300000 - 0x813000FF	APWM CF0 Timer and synchronization	Yes
	APWMCF	0x81301000 - 0x813010FF	APWM CF0 0	Yes
	APWMCF	0x81302000 - 0x813020FF	APWM CF0 1	Yes
	APWMCF	0x81303000 - 0x813030FF	APWM CF0 2	Yes
	APWMCF	0x81304000 - 0x813040FF	APWM CF0 3	Yes
	REGSYNCCF	0x81305000 - 0x813050FF	APWM CF1 Timer and synchronization	Yes
	APWMCF	0x81306000 - 0x813060FF	APWM CF1 0	Yes
	APWMCF	0x81307000 - 0x813070FF	APWM CF1 1	Yes
	APWMCF	0x81308000 - 0x813080FF	APWM CF1 2	Yes
	APWMCF	0x81309000 - 0x813090FF	APWM CF1 3	Yes
	Not used	0x8130A000 - 0x8130A0FF	-	Yes
	Not used	0x8130B000 - 0x8130B0FF	-	Yes
	Not used	0x8130C000 - 0x8130C0FF	-	Yes
	Not used	0x8130D000 - 0x8130D0FF	-	Yes
	Not used	0x8130E000 - 0x8130E0FF	-	Yes
	Not used	0x8130F000 - 0x8130F0FF	-	Yes

# LEON3FT Microcontroller

Table 18. AMBA memory map, as seen from processors

Core	Address range	Area	RTA Access	
A P B C T R L 8	REGSYNCCF	0x81400000 - 0x814000FF	APWM CF2 Timer and synchronization	Yes
	APWMCF	0x81401000 - 0x814010FF	APWM CF2 0	Yes
	APWMCF	0x81402000 - 0x814020FF	APWM CF2 1	Yes
	APWMCF	0x81403000 - 0x814030FF	APWM CF2 2	Yes
	APWMCF	0x81404000 - 0x814040FF	APWM CF2 3	Yes
	Not used	0x81405000 - 0x814050FF	-	Yes
	Not used	0x81406000 - 0x814060FF	-	Yes
	Not used	0x81407000 - 0x814070FF	-	Yes
	Not used	0x81408000 - 0x814080FF	-	Yes
	Not used	0x81409000 - 0x814090FF	-	Yes
	Not used	0x8140A000 - 0x8140A0FF	-	Yes
	Not used	0x8140B000 - 0x8140B0FF	-	Yes
	Not used	0x8140C000 - 0x8140C0FF	-	Yes
	Not used	0x8140D000 - 0x8140D0FF	-	Yes
	Not used	0x8140E000 - 0x8140E0FF	-	Yes
	Not used	0x8140F000 - 0x8140F0FF	-	Yes
A P B C T R L 9	APWMG	0x81500000 - 0x815000FF	APWMG 0 (with One Shot Timer)	Yes
	APWMG	0x81501000 - 0x815010FF	APWMG 1 (with One Shot Timer)	Yes
	APWMG	0x81502000 - 0x815020FF	APWMG 2 (with One Shot Timer)	Yes
	APWMG	0x81503000 - 0x815030FF	APWMG 3 (with One Shot Timer)	Yes
	APWMG	0x81504000 - 0x815040FF	APWMG 4	Yes
	APWMG	0x81505000 - 0x815050FF	APWMG 5	Yes
	APWMG	0x81506000 - 0x815060FF	APWMG 6	Yes
	APWMG	0x81507000 - 0x815070FF	APWMG 7	Yes
	APWMG	0x81508000 - 0x815080FF	APWMG 8	Yes
	APWMG	0x81509000 - 0x815090FF	APWMG 9	Yes
	APWMG	0x8150A000 - 0x8150A0FF	APWMG 10	Yes
	APWMG	0x8150B000 - 0x8150B0FF	APWMG 11	Yes
	APWMG	0x8150C000 - 0x8150C0FF	APWMG 12	Yes
	APWMG	0x8150D000 - 0x8150D0FF	APWMG 13	Yes
	APWMG	0x8150E000 - 0x8150E0FF	APWMG 14	Yes
APWMG	0x8150F000 - 0x8150F0FF	APWMG 15	Yes	



# LEON3FT Microcontroller

Table 18. AMBA memory map, as seen from processors

Core	Address range	Area	RTA Access	
A P B C T R L D B G	AHBUART	0x94000000 - 0x940000FF	AHB Debug UART	No
	L3STAT	0x94001000 - 0x940013FF	LEON3 Statistics Unit	No
	GRGPREG	0x94002000 - 0x940020FF	Analog test control	No
	GRGPREG	0x94003000 - 0x94003FFF	Memory test control and status register	No
	GRGPREG	0x94004000 - 0x94004FFF	Analog test control	No
	GRGPREG	0x94005000 - 0x94005FFF	Analog test control	No
	GRGPREG	0x94006000 - 0x94006FFF	Debug configuration register 1	No
	GRGPREG	0x94007000 - 0x94007FFF	Debug configuration register 2	No
	-	0x94008000 - 0x94008FFF	Unused	-
	-	0x94009000 - 0x94009FFF	Unused	-
-	0x9400A000 - 0x9400AFFF	Unused	-	
-	0x9400B000 - 0x9400BFFF	Unused	-	
-	0x9400C000 - 0x9400CFFF	Unused	-	
-	0x9400D000 - 0x9400DFFF	Unused	-	
-	0x9400E000 - 0x9400EFFF	Unused	-	
-	0x9400F000 - 0x9400FFFF	Unused	-	
DSU3	0x90000000 - 0x905FFFFFFF	LEON3 Debug Support Unit	Yes	
DSU3 RTA 0	0x90060000 - 0x906FFFFFFF	LEON3 Debug Support Unit for RTA 0	Yes	
DSU3 RTA 1	0x90070000 - 0x907FFFFFFF	LEON3 Debug Support Unit for RTA 1	Yes	
-	0x94000000 - 0x940FFFFFFF	APB bus DBG address space	Yes	
AHBTRACE1	0x9ff20000 - 0x9ff3FFFF	AHB Trace Buffer	Yes	
-	0x9FFFF000 - 0x9FFFFFFF	Configuration area for Debug bus	Yes	
MEMSCRUB	0xFFFF0000 - 0xFFFF00FF	Memory scrubber registers	Yes	
SPIMCTRL	0xFFFF00100 - 0xFFFF001FF	SPIMCTRL control registers 0	Yes	
SPIMCTRL	0xFFFF00200 - 0xFFFF002FF	SPIMCTRL control registers 1	Yes	
-	0xFFFFF000 - 0xFFFFFFF	Configuration area for system main bus	Yes	

Accesses to unused AMBA AHB address space will result in an AMBA ERROR response, this applies to the memory areas that are marked as "Unused" in the table above. Accesses to unused areas located on one of the AHB/APB bridges will not have any effect, note that these unoccupied address ranges are not marked as "Unused" in the table above. No AMBA ERROR response will be given for memory allocated to one of the APB bridges.

## 2.11 Atomic access

This chapter describes how atomic read and modify operations are performed in the GR716B microcontroller. The GR716B microcontroller supports atomic read-modify-write operations in hardware by mirroring the address space of the peripheral and internal data memory for different atomic operations. Atomic operations supported are OR, AND, XOR and Set&Clear.

Atomic access is only supported locally in the GPIO functionally in GR716B.

# LEON3FT Microcontroller

## 2.12 Interrupts

The table below indicates the interrupt default assignments. All interrupts are handled by the interrupt controller and forwarded to the LEON3 processors. For more configuration and option see chapter 40

Table 19. Bus Interrupt line assignments. TBC. Interrupt ID not fully documented yet. APWM interrupts not included.

Interrupt ID	Interrupt Line	Core	Comment
	0	n/a	not used
1	1	Extended	Extended Interrupts for primary interrupt controller
2	2	GRPWRX	Interrupt from PacketWire RX controller
3	3	GRPWTX/GRSCRUB	Shared interrupt line from PacketWire TX controller and GRSCRUB (TBC).
4	4	GR1553B	Interrupt from GR1553 controller
5	5	GRSPWROUTER	Interrupt from SpaceWire router
6	6	GRDMAC0/ GRDMAC1	DMA controller interrupt 0 - 1
7	7	I2CSLV0	Interrupt from I2C Slave 0 (TBC)
8	8		
9	9	GPTIMER0	Interrupt 1 from timer block 0
10	10	GPTIMER0	Interrupt 2 from timer block 0
11	11	GPTIMER0 / APWM (TBC)	Interrupt 3 from timer block 0
12	12	GPTIMER0	Interrupt 4 from timer block 0
13	13	GPTIMER0	Interrupt 5 from timer block 0
14	14	GPTIMER0	Interrupt 6 from timer block 0
15	15	GPTIMER0	Interrupt 7 from timer block 0 (WDOG)
16	16	Unused	-
17	17	GRGPIO0	Interrupt from GPIO controller 0
18	18	GRGPIO0	(Interrupt from GPIO controller 0)
19	19	GRGPIO0	(Interrupt from GPIO controller 0)
20	20	GRGPIO0	(Interrupt from GPIO controller 0)
21	21	GRCANFD	Interrupt from CANFD controller
22	22	GRCANFD	TxSYNC interrupt from CANFD controller
23	23	GRCANFD	RxSYNC interrupt from CANFD controller
24	24	APBUART0	Interrupt from APBUART interface 0
25	25	APBUART1	Interrupt from APBUART interface 1
26	26	DAC0	Interrupt from on-chip DAC 0
27	27	DAC1	Interrupt from on-chip DAC 1
28	28	ADC0	Interrupt from on-chip ADC 0
29	29	ADC1	Interrupt from on-chip ADC 1
30	30	ADC2	Interrupt from on-chip ADC 2
31	31	ADC3	Interrupt from on-chip ADC 3
28	32	Unused	-
29	33	Unused	-
30	34	Unused	-
31	35	Unused	-

# LEON3FT Microcontroller

Table 19. Bus Interrupt line assignments. TBC. Interrupt ID not fully documented yet. APWM interrupts not included.

Interrupt ID	Interrupt Line	Core	Comment
26	36	DAC2	on-chip DAC 2 interrupt
27	37	DAC3	on-chip DAC 3 interrupt
16	38	GRGPIO1	Interrupt from GPIO controller 1
17	39	GRGPIO1	(Interrupt from GPIO controller 1)
18	40	GRGPIO1	(Interrupt from GPIO controller 1)
19	41	GRGPIO1	(Interrupt from GPIO controller 1)
3	42	APBUART2	APBUART interface interrupt 2
4	43	GRSPWTDTP	SpaceWire TDP
5	44	APBUART3	APBUART interface interrupt 3
6	45	APBUART4	APBUART interface interrupt 4
7	46	APBUART5	APBUART interface interrupt 5
8	47	I2CSLV1 / I2C2AHB	Interrupt line shared between I2C Slave Interface 1 and I2C2 to AHB bridge
11	48	SPICTRL0	Interrupt from SPI controller 0
12	49	SPICTRL1	Interrupt from SPI controller 1
13	50	I2CM0	Interrupt from I2C master controller 0
14	51	I2CM1	Interrupt from I2C master controller 1
2	52	SPIMCTRL0 / SPIMCTRL1	Interrupt from SPI memory controllers 0 and 1
20	53	GPTIMER1	Interrupt 1 from timer block 1
21	54	GPTIMER1	Interrupt 2 from timer block 1
22	55	GPTIMER1	Interrupt 3 from timer block 1
23	56	GPTIMER1	Interrupt 4 from timer block 1
24	57	GPTIMER1	Interrupt 5 from timer block 1
25	58	GPTIMER1	Interrupt 6 from timer block 1
26	59	GPTIMER1	Interrupt 7 from timer block 1
TBD	60	GRSEQ0	Interrupt from RTA sequencer 0
TBD	61	GRSEQ1 / GRETH	Interrupt line shared between RTA sequencer 1 and Ethernet MAC
18	62 (TBC)	PLL	PLL interrupt, Power On Reset and Brown Out interrupt
TBD	62	SPI2AHB / SPI4S	Interrupt line shared between SPI to AHB bridge and SPI for space slave controller
19	63	AHBSTAT/DLRAM, ILRAM/GRGPRBANK/MEMSCRUB/MEMPROT	AHB status, Scrubbers and I/O mux interrupt. (TBD)

# LEON3FT Microcontroller

## 3 Signals

### 3.1 Bootstrap signals

The power-up and initialisation state is affected by several external signals as shown in table 20. The bootstrap signals taken via GPIO, DUART and SPIM signals are saved when the on-chip system reset is released. This occurs after deassertion of the internal power-on-reset or RESET\_IN\_N input and valid input clock on the SYS\_CLK pin. The state of the signals are sampled and stored in a bootstrap register. See section 7.2 for boot strap register description.

Note that some pins used for bootstrapping have dual purpose can be used for normal operations after reset has been released.

Table 20. Bootstrap signals

Pin	Functional description
DSU_EN	Enables the Debug Support Unit (DSU) and other members connected to the Debug AHB bus. If DSU_EN is HIGH the DSU and the Debug AHB bus will be clocked. If DSU_EN is LOW the DSU and all members on the Debug AHB bus will be clock gated off.
DSU_BREAK	Puts processor in debug mode when asserted while DSU_EN is HIGH. When DSU_EN is LOW, BREAK is assigned to the timer enable bit of the watchdog timer and also controls if the processor starts executing after reset.
GPIO[17]	Enable bypass of internal boot ROM. Boot strapping this signal 'high' will force the processor NOT to execute the internal boot software. Normally the processor starts executing from address 0x0. But if this bootstrap is 'high' the processor will start execute from software from address selected by bootstrap signals SPIM_MOSI & SPIM_SCK & SPIM_SEL.
GPIO[0]	Determines the use of EDAC for external boot RAM when the GR716 microcontroller shall boot from external memory. Set to low for enabling EDAC and to high for disabling EDAC. Determines the use of PLL when the GR716 microcontroller shall boot via a remote source. Set to high for enabling PLL and to low for disabling PLL. Determines bit 0 of the I2C node ID (ID[0]). When using CAN-FD remote boot PLL must be disabled. CAN-FD node ID[0] is fixed to '0'.
GPIO[1]	Determines the selection of nominal or redundant bus for CAN-FD. Set to low for nominal bus, and high for redundant bus.
GPIO[15]	Determines bit 2 of the CAN-FD and I2C node ID (ID[2]).
GPIO[18]	When remote access is enabled (SPIM_MOSI is high), GPIO[18] enables/disables CAN-FD remote boot. Set high to enable, low to disable.
GPIO[62]	Enable test of internal memories at startup. The processor starts checking internal memory for bit errors during boot if this bootstrap is set to 'high'. Setting this to 'high' will slow down the boot processes since the check is software based. Determines bit 1 of the CAN-FD and I2C node ID (ID[1]).
GPIO[63]	Enables extra protection of external boot source or setting SpaceWire clock frequency. If boot from external RAM/ROM this pin enable the use of redundant memory if primary boot memory fails. High to enable, low to disable. If remote access via SPW this pin together with DUART_TXD is used to set the SpaceWire default speed. If remote access via CAN-FD this pin together with DUART_TXD is used to set the CAN default bit rate.

# LEON3FT Microcontroller

Table 20. Bootstrap signals

Pin	Functional description
DUART_TXD	<p>If boot from external SRAM/ROM/SPI-ROM this pin are used for selecting to copy ASW image from selected external boot RAM/ROM (If not set for this option. The GR716 microcontroller will start execute from the selected external memory)</p> <p>If remote access via SPW is selected then this pin together with GPIO[63] is used to set the SPW default speed. Set DUART_TXD &amp; GPIO[63] accordingly depending on external SpaceWire frequency:</p> <p>"00" - For 50 MHz external frequency source            "01" - For 10 MHz external frequency source            "10" - For 20 MHz external frequency source            "11" - For 25 MHz external frequency source</p> <p>If remote access via CAN-FD is selected then this pin together with GPIO[63] is used to set the Bit-Rate Configuration Register of CAN-FD adapted to the internal AMBA clock frequency. Set DUART_TXD &amp; GPIO[63] accordingly depending on internal AMBA clock frequency:</p> <p>"00" - For 10 MHz internal AMBA clock frequency            "01" - For 20 MHz internal AMBA clock frequency            "10" - For 25 MHz internal AMBA clock frequency            "11" - For 50 MHz internal AMBA clock frequency</p> <p>The CAN-FD bit-rate when remote boot is enabled is fixed to 0.125 Mbit/s.</p>
SPIM_MOSI	<p>Enable remote access (high to enable, low to disable). When remote access is disabled, the processor will either (depending on DUART_TXD) start or copy a software image from the selected external boot memory. When remote access is enabled, the processor will (after initialization and memory tests) be placed in a halted state but remote access to the internal bus will be enabled through SPI, SpaceWire RMAP, I2C, UART or CAN-FD.</p>
SPIM_SCK & SPIM_SEL	<p>This pin together with the pin SPIM_MOSI selects which source the LEON3FT microcontroller should boot from:</p> <p>When copy ASW boot from external source is selected (SPIM_MOSI is low)</p> <p>"00" - Copy software image from SPI Memory            "01" - Copy software image from external SRAM            "10" - Copy software image from external ROM            "11" - Unused (Will result in copy of software image from SPI Memory)</p> <p>When boot from external source is selected (SPIM_MOSI is low)</p> <p>"00" - Boot from SPI Memory            "01" - Boot from external SRAM            "10" - Boot from external ROM            "11" - Unused (Will result in boot from SPI Memory)</p> <p>Enable for remote access interfaces (SPIM_MOSI is high)</p> <p>"00" - SPI remote access            "01" - SpaceWire RMAP enable            "10" - I2C remote access            "11" - UART remote access</p> <p>Dedicated pin GPIO[18] available for CAN-FD boot.</p>

- Note 1: User should use weak pull-up/pull-downs for configuration of the GR716B microcontroller. A weak resistor is defined as resistor which require low current from the drive circuitry. The resistance should be greater or equal to 10K ohm.
- Note 2: Bootstrap signals determine state of GR716B microcontroller after reset has been released.
- Note 3: The LEON3FT processor is always enabled after reset has been released.

# LEON3FT Microcontroller

Table 20. Bootstrap signals

Pin	Functional description
Note 4:	Remote access request will force the processor to power down according to 17.2.16 after initialization has been completed.
Note 5:	Remote access will enable clocks according to table: <ol style="list-style-type: none"> <li>1. SpaceWire option will enable SpaceWire core and external SpaceWire interface</li> <li>2. SPI option will enable SPI for Space Slave and external SPI for Space interface</li> <li>3. I2C option will enable I2C core and external I2C interface</li> <li>4. UART option will enable AHBUART1 and external UART interface</li> <li>5. CAN-FD option will enable CAN-FD core and external CAN interface</li> </ol>
Note 6:	Only requested memory interface will have clock and pins enabled.
Note 7:	Watchdog timer will always be enabled and not controllable from bootstraps.

# LEON3FT Microcontroller

## 3.1.1 Boot strap configuration for remote access

This section describes valid bootstrap configuration for remote access:

Table 21. Remote bootstrap configurations

Pin									Functional description
Remote Access	Source <sup>7)</sup>			SpaceWire Divisor		PLL <sup>4) 5)</sup>	Boot Bypass	Memory test	
SPIM_MOSI	SPIM_SCK	SPIM_SEL	GPIO[18]	DUART_TXD	GPIO[63]	GPIO[0]	GPIO[17]	GPIO[62]	
high	low	high	low	low	low	high	low	low	Enable SpaceWire remote access using a 50 MHz SPWCLK input clock after initialization of the processor.
high	low	high	low	low	low	high	low	high	Enable SpaceWire remote access using a 50 MHz SPWCLK input clock after initialization of the processor and internal memory test.
high	low	high	low	low	high	high	low	low	Enable SpaceWire remote access using a 10 MHz SPWCLK input clock after initialization of the processor
high	low	high	low	low	high	high	low	high	Enable SpaceWire remote access using a 10 MHz SPWCLK input clock after initialization of the processor and internal memory test.
high	low	high	low	high	low	high	low	low	Enable SpaceWire remote access using a 20 MHz SPWCLK input clock after initialization of the processor
high	low	high	low	high	low	high	low	high	Enable SpaceWire remote access using a 20 MHz SPWCLK input clock after initialization of the processor and internal memory test.
high	low	high	low	high	high	high	low	low	Enable SpaceWire remote access using a 25 MHz SPWCLK input clock after initialization of the processor
high	low	high	low	high	high	high	low	high	Enable SpaceWire remote access using a 25 MHz SPWCLK input clock after initialization of the processor and internal memory test.

# LEON3FT Microcontroller

Table 21. Remote bootstrap configurations

Pin									Functional description
Remote Access	Source <sup>7)</sup>			SpaceWire Divisor		PLL <sup>4) 5)</sup>	Boot Bypass	Memory test	
SPIM_MOSI	SPIM_SCK	SPIM_SEL	GPIO[18]	DUART_TXD	GPIO[63]	GPIO[0]	GPIO[17]	GPIO[62]	
high	low	high	low	x <sup>2)</sup>	x <sup>2)</sup>	low	low	low	Enable SpaceWire remote access using the clock direct from the SpaceWire input pin after initialization of the processor
high	low	high	low	x <sup>2)</sup>	x <sup>2)</sup>	low	low	high	Enable SpaceWire remote access using the clock direct from the SpaceWire input pin after initialization of the processor and internal memory test.
high	low	low	low	x <sup>2)</sup>	x <sup>2)</sup>	x <sup>2)</sup>	low	low	Enable SPI remote access after initialization of the processor.
high	low	low	low	x <sup>2)</sup>	x <sup>2)</sup>	x <sup>2)</sup>	low	high	Enable SPI remote access after initialization of the processor and internal memory test.
high	high	low	low	x <sup>2)</sup>	x <sup>2)</sup>	x <sup>2)</sup>	low	low	Enable I2C remote access after initialization of the processor.
high	high	low	low	x <sup>2)</sup>	x <sup>2)</sup>	x <sup>2)</sup>	low	high	Enable I2C remote access after initialization of the processor and internal memory test.
high	high	high	low	x <sup>2)</sup>	x <sup>2)</sup>	x <sup>2)</sup>	low	low	Enable UART remote access after initialization of the processor.
high	high	high	low	x <sup>2)</sup>	x <sup>2)</sup>	x <sup>2)</sup>	low	high	Enable UART remote access after initialization of the processor and internal memory test.
high	low	low	high	low	low	low	low	low	Enable CAN-FD CANOPEN remote access using a 10 MHz SYS_CLK after initialization of the processor.
high	low	low	high	low	low	low	low	high	Enable CAN-FD CANOPEN remote access using a 10 MHz SYS_CLK after initialization of the processor and internal memory test.
high	low	low	high	low	high	low	low	low	Enable CAN-FD CANOPEN remote access using a 20 MHz SYS_CLK after initialization of the processor.



# LEON3FT Microcontroller

Table 21. Remote bootstrap configurations

Pin									Functional description
Remote Access	Source <sup>7)</sup>			SpaceWire Divisor		PLL <sup>4) 5)</sup>	Boot Bypass	Memory test	
SPIM_MOSI	SPIM_SCK	SPIM_SEL	GPIO[18]	DUART_TXD	GPIO[63]	GPIO[0]	GPIO[17]	GPIO[62]	
high	low	low	high	low	high	low	low	high	Enable CAN-FD CANOPEN remote access using a 20 MHz SYS_CLK after initialization of the processor and internal memory test.
high	low	low	high	high	low	low	low	low	Enable CAN-FD CANOPEN remote access using a 25 MHz SYS_CLK after initialization of the processor.
high	low	low	high	high	low	low	low	high	Enable CAN-FD CANOPEN remote access using a 25 MHz SYS_CLK after initialization of the processor and internal memory test.
high	low	low	high	high	high	low	low	low	Enable CAN-FD CANOPEN remote access using a 50 MHz SYS_CLK after initialization of the processor.
high	low	low	high	high	high	low	low	high	Enable CAN-FD CANOPEN remote access using a 50 MHz SYS_CLK after initialization of the processor and internal memory test.

Note 1: To enable remote access SPIM\_MOSI must be bootstrapped to high.

Note 2: Configuration pin has no effect or not used for bootstrap configuration. It recommend to tie the pin to either low or high.

Note 3: Processor are forced into power down mode after processor and memory test has been completed.

Note 4: Enable internal PLL by bootstrap signal to high. When using the internal PLL the link speed will be set to 10 Mbps after reset and maximum link speed after auto negotiation of link speed is 100 Mbps.

Note 5: Disable internal PLL by bootstrap signal to low. When bypassing the internal PLL the speed will be set to input frequency of the SpaceWire clock. The PLL will be in power down mode.

Note 6: Refer section 3.1 for detailed description of bootstrap signals.

Note 7: When remote access via I2C or CAN-FD is selected, 3 bits of the I2C address and CANOPEN node ID are partially determined by bootstrap pins. The CANOPEN node ID is set to 0b0000xxx while I2C memory and configuration addresses are set to 0b101xxx0 and 0b101xxx1. The bits "xxx" are taken from bootstrap pins: GPIO[15] & GPIO[62] & GPIO[0]. (TBD)

# LEON3FT Microcontroller

## 3.1.2 Boot strap configuration for external SPI memory

This section describes valid bootstrap configuration for use of external memory options:

Table 22. External SPI memory bootstrap configurations

Pin									Functional description
Remote Access	Source			ASW <sup>3)</sup>	Red <sup>4)</sup>	EDAC <sup>5)</sup>	Bypass <sup>6)</sup>	Memory test	
SPIM_MOSI	SPIM_SCK	SPIM_SEL	GPIO[18]	DUART_TXD	GPIO[63]	GPIO[0]	GPIO[17]	GPIO[62]	
low	low	low	low	low	low	5)	low	7)	Enable external SPI memory boot. Processor will start execute application software direct from memory after initialization of the processor.
low	low	low	low	low	low	5)	high	7)	Enable external SPI memory boot. Processor will start execute application software direct from memory.
low	low	low	low	high	low	5)	low	low	Enable external ASW SPI memory boot after initialization of the processor. Processor will copy and extract ASW container before executing application software.
low	low	low	low	high	high	5)	low	low	Enable external ASW SPI memory with DMR protection boot after initialization of the processor. Processor will copy and extract ASW container before executing application software.

Note 1: To enable external memory access SPIM\_MOSI must be bootstrapped to low.

Note 2: Configuration pin has no effect or not used for bootstrap configuration. It recommend to tie the pin either to low or high.

Note 3: Enable ASW protection. ASW protection usage is described in section 51.

Note 4: Enable dual module redundancy protection. Option only valid in combination with ASW protection. Redundant memory is expected to located at 0x04000000.

Note 5: Enable BCH EDAC protection. EDAC can be enabled and used in combination with all other options. When configuration is used external memory must included BCH check bits.

Note 6: Enable bypass of the internal boot ROM. When enabled the processor will start execute code directly from the primary memory at 0x02000000. Processor or internal memory is initialized after reset when this option is used.

Note 7: Enable memory test. Memory test configuration can be used in combination with all other options. Memory test have no affect when internal boot ROM is bypassed.

# LEON3FT Microcontroller

## 3.1.3 Boot strap configuration for external SRAM memory

This section describes valid bootstrap configuration for use of external memory options:

Table 23. External SRAM memory bootstrap configurations

Pin								Functional description
Remote Access	Source		ASW <sup>3)</sup>	Red <sup>4)</sup>	EDAC <sup>5)</sup>	Bypass <sup>6)</sup>	Memory test	
SPIM_MOSI GPIO[18]	SPIM_SCK	SPIM_SEL	DUART_TXD	GPIO[63]	GPIO[0]	GPIO[17]	GPIO[62]	
low	low	high	low	low	5)	low	7)	Enable external SRAM memory boot. Processor will start execute application software direct from memory after initialization of the processor.
low	low	high	low	low	5)	high	7)	Enable external SRAM memory boot. Processor will start execute application software direct from memory.
low	low	high	high	low	5)	low	low	Enable external ASW SRAM memory boot after initialization of the processor. Processor will copy and extract ASW container before executing application software.
low	low	high	high	high	5)	low	low	Enable external ASW SRAM memory with DMR protection boot after initialization of the processor. Processor will copy and extract ASW container before executing application software.

Note 1: To enable external memory access SPIM\_MOSI must be bootstrapped to low.

Note 2: Configuration pin has no effect or not used for bootstrap configuration. It recommend to tie the pin either to low or high.

Note 3: Enable ASW protection. ASW protection usage is described in section 51.

Note 4: Enable dual module redundancy protection. Option only valid in combination with ASW protection. Redundant memory is expected to be located at address allocated for external chip select signal 1.

Note 5: Enable BCH EDAC protection. EDAC can be enabled and used in combination with all other options. When configuration is used external memory must included BCH check bits.

Note 6: Enable bypass of the internal boot ROM. When enabled the processor will start execute code directly from the primary memory at 0x40000000. Processor or internal memory is initialized after reset when this option is used.

Note 7: Enable memory test. Memory test configuration can be used in combination with all other options. Memory test have no affect when internal boot ROM is bypassed.

# LEON3FT Microcontroller

## 3.1.4 Boot strap configuration for external PROM/FLASH memory

This section describes valid bootstrap configuration for use of external memory options:

Table 24. External PROM/FLASH memory bootstrap configurations

Pin								Functional description
Remote Access	Source		ASW <sup>3)</sup>	Red <sup>4)</sup>	EDAC <sup>5)</sup>	Bypass <sup>6)</sup>	Memory test	
SPIM_MOSI GPIO[18]	SPIM_SCK	SPIM_SEL	DUART_TXD	GPIO[63]	GPIO[0]	GPIO[17]	GPIO[62]	
low	high	low	low	low	5)	low	7)	Enable external PROM/FLASH memory boot. Processor will start execute application software direct from memory after initialization of the processor.
low	high	low	low	low	5)	high	7)	Enable external PROM/FLASH memory boot. Processor will start execute application software direct from memory.
low	high	low	high	low	5)	low	low	Enable external ASW PROM/FLASH memory boot after initialization of the processor. Processor will copy and extract ASW container before executing application software.
low	high	low	high	high	5)	low	low	Enable external ASW PROM/FLASH memory with DMR protection boot after initialization of the processor. Processor will copy and extract ASW container before executing application software.

Note 1: To enable external memory access SPIM\_MOSI must be bootstrapped to low

Note 2: Configuration pin has no effect or not used for bootstrap configuration. It recommend to tie the pin either to low or high.

Note 3: Enable ASW protection. ASW protection usage is described in section 51.

Note 4: Enable dual module redundancy protection. Option only valid in combination with ASW protection. Redundant memory is expected to be located at address allocated for external chip select signal 1.

Note 5: Enable BCH EDAC protection. EDAC can be enabled and used in combination with all other options. When configuration is used external memory must included BCH check bits.

Note 6: Enable bypass of the internal boot ROM. When enabled the processor will start execute code directly from the primary memory at 0x01000000. Processor or internal memory is initialized after reset when this option is used.

Note 7: Enable memory test. Memory test configuration can be used in combination with all other options. Memory test have no affect when internal boot ROM is bypassed.

# LEON3FT Microcontroller

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## 3.2 Configuration for flight

To achieve the intended functionality in flight, certain signals must be held at a fixed configuration:

- DUART\_RXD must have an external pull-down resistor to avoid any erroneous trigger on noise injected on the debug interface.
- DSUEN can be pulled-down to disable debug capabilities in flight, if not used.

# LEON3FT Microcontroller

## 4 Clocking

Up to six unique external clock sources connected on five external input pins: SYS\_CLK, SPW\_CLK, PWRX\_CLK, GR1553\_CLK, SPI4S\_CLK, ETH\_CLK sources can be used for generating different clocks in the GR716B Microcontroller. Internal clock generation using SYS\_CLK/SPW\_CLK is supported to control asynchronous interface for the SCRUBBER\_CLK, ADC, DAC, FIR and APWM DAC. Note that external PacketWire, SPI4Sclock and ETH\_CLK is only accessible via the IO switch matrix

Table 25. Clock inputs

Clock input	Description	Frequency Range
ADC_CLK	ADC clock generated from internal logic used for clocking and control of ADC	up to 10 MHz
DAC_CLK	DAC clock generated from internal logic used for clocking and control of the DAC	up to 25 MHz
APWM_DAC	APWM_DAC clock generated from internal logic used for clocking and control of the APWM_DAC	up to 25 MHz
FIR	FIR sample clock generated from internal logic used for clocking and control of the FIR block	up to 25 MHz (TBC)
SYS_CLK	System clock input	up to 100 MHz <sup>5)</sup>
SPW_CLK	SpaceWire clock	up to 200 MHz <sup>2)</sup>
GR1553_CLK	MIL-STD-1553B interface clock (Only valid via PIN muxing)	20 MHz <sup>3)</sup>
SPI4S_CLK	SPI for Space clock	up to 25 MHz
PWRX_CLK	PacketWire receive clock	up to 25 MHz <sup>1)</sup>
PWTX_CLK	PacketWire loop-back clock for test purpose	up to 25 MHz <sup>1)</sup>
ETH_CLK	Ethernet transmit and receiver clock	up to 25 MHz
SCRUBBER_CLK	FPGA Scrubber used for communication with external FPGA	up to 25 MHz

Note 1: Frequency shall be equal or lesser than system clock frequency divided by 4

Note 2: Duty cycle for SpaceWire clock shall be set to 50/50 for best jitter performance

Note 3: Duty cycle for MIL-STD-1553B clock shall be at least 40%

Note 4: Frequency shall be equal or lesser than system clock frequency divided by 2

Note 5: System clock must at all time be supplied to the system

The ADC\_CLK is generated via control registers for the internal ADC, see chapter 12.

There are four internal DAC\_CLK clocks. Each DAC\_clock is generated individually via control registers, see chapter 15.

The APWM\_DAC clock is generated via control registers, see chapter 54.

There are eight FIR blocks. The FIR sample clocks are generated using two clock generator blocks, see chapter 16.

The SYS\_CLK pin is used as the main system clock, and directly drive the clock network without PLL. The SYS\_CLK is selected by default as system clock. The system clocks shall always be running during reset and normal operation.

The SPW\_CLK pin is the external SpaceWire clock, and it can be used to generate the internal clocks directly or multiplied with a PLL, depending on the value of the configuration registers in PLL configuration block, see chapter 10.

The GR1553\_CLK pin is the external MIL-1553B 20 MHz clock and can be used if MIL-1553B interface requires external clock.

# LEON3FT Microcontroller

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The PWRX\_CLK pin is the external PacketWire Receiver clock and is used if PacketWire receiver interface is enabled.

The SCRUBBER\_CLK is generated from the internal systems clock by dividing the internal system clock with a factor of 4,8,16 or 32.

The ETH\_CLK should be supplied from an external source.

The microcontroller PLL can be used to generate frequencies required for SpaceWire, 1553B or the system clock. The lowest frequency to be used with the integrated PLL is 5 MHz to be able to meet jitter performance for SpaceWire (with ideal supply). The clock divider block, which supplies the internal SpaceWire clock, can be configured to generate a maximum clock frequency of 100 MHz. However, if a 200 MHz clock is required for the internal SpaceWire clock, it cannot be achieved using the PLL and clock divisor block. In such a case, the external SpaceWire clock must be directly supplied with a 200 MHz clock, and the PLL must be bypassed using the configuration registers described in section 10.

Clock distribution and configuration in the microcontroller is shown in figure 16. In figure 16 the 'blue', 'green' and 'grey' boxes represents logic. External pins are marked with 'names' for cross reference to the pin list in section 2.5. Control registers accessible via software or external boot-straps in order to setup and configure clocks in the system are named using the format `<register name>.<bit-field>`.

# LEON3FT Microcontroller

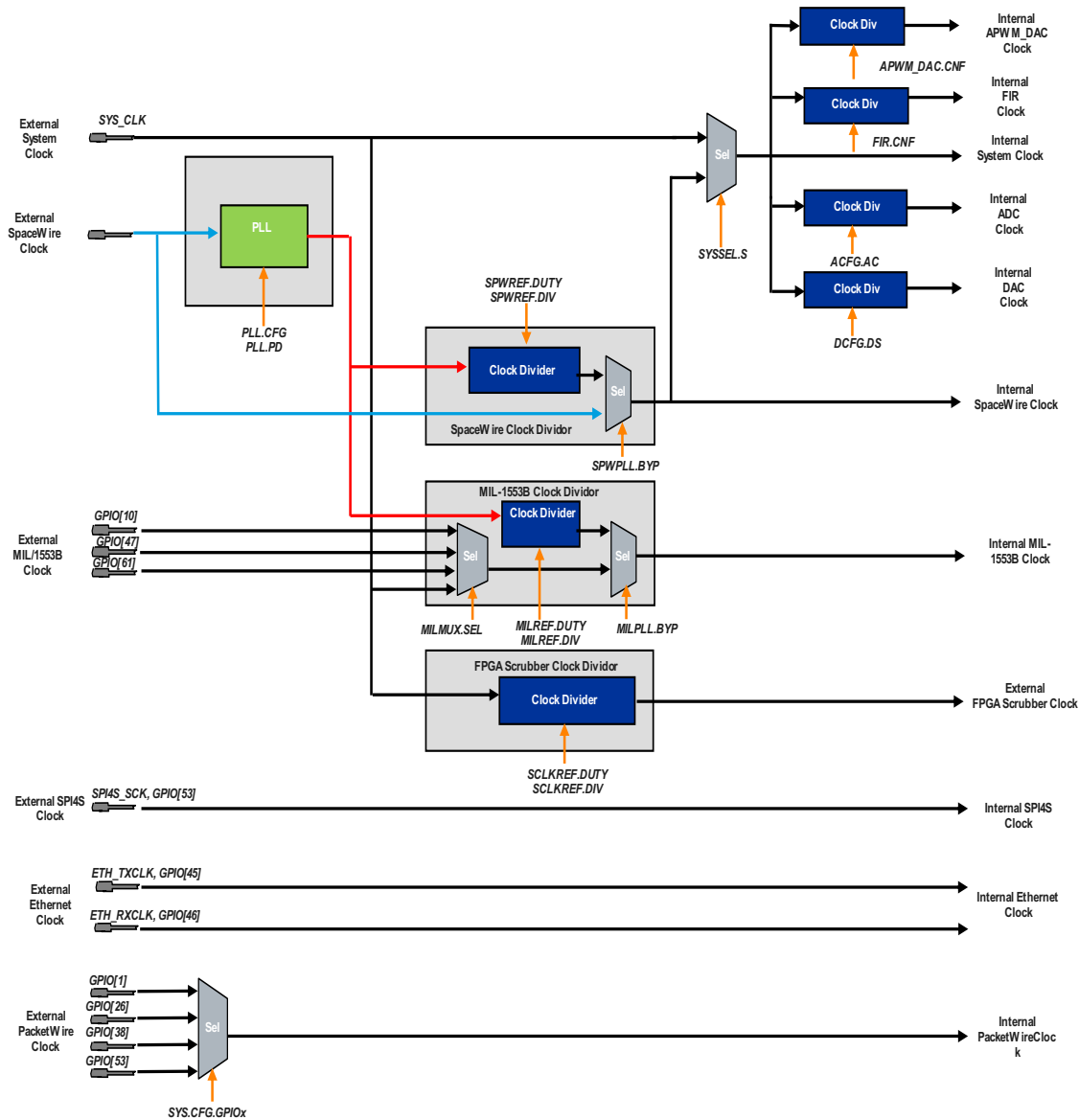


Figure 16. GR716B microcontroller clock distribution scheme and control register.

## 4.1 PLL Configuration and Status

The PLL is designed to mitigate radiation effects and to always output 400 MHz. In order to lock and generate a 400 MHz output clock the PLL needs to be programmed with the input clocks frequency. The input clock frequency is set via PLL control and status registers, see section 10.

When the GR716B Microcontroller is configured to be controlled via remote access the PLL is configured automatically after reset by the hardware. The setup used is determined by configuration bootstraps specified in chapter 3.1. The input frequency needs to be known by the hardware in order to properly setup and synchronize the remote access link.

## 4.2 Clock Source and divisor

The system clock, SpaceWire clock, FPGA Scrubber and GR1553B clock can be generated internally from internal or external sources, see figure 16 and section 10. Clock source and divisor is selected via configuration registers described in section 10.



# LEON3FT Microcontroller

The clock source and divisor needs to be chosen carefully depended upon the application requirements for clock frequency, clock jitter and clock duty cycle.

## 4.3 System clock

The internal system clock is used to clock the processors, the AMBA buses, and all on-chip cores. This clock can be derived directly from input pin `SYS_CLK` or from the external pin `SPW_CLK` via the internal PLL.

### 4.3.1 System clock source selection

The internal system clock can be configured to run slower or faster than the external `SPW_CLK`. Special care needs to be taken when switching system clock source in order to switch to a existing clock source. The device will automatically switch back to use the default system input clock during reset and if the system tries to switch to a disabled clock source.

### 4.3.2 Internal crystal oscillator (XO)

The microcontroller includes an on-chip oscillator able to provide a 5 - 25 MHz internal clock. This clock can optionally be used to generate other on-chip clocks for the processor system, SpaceWire and MIL-STD-1553B. To be able to provide a high-accuracy reference clock a crystal oscillator is implemented, where the active oscillator part is implemented on-chip and the crystal is to be connected externally. Alternatively, any arbitrary clock source can be applied as a logic-level clock signal on one of the crystal-interface input pins.

The output from the on-chip oscillator needs to be connected outside the microcontroller device if to used. Refer section 9 for further information on on-chip crystal oscillator.

## 4.4 SpaceWire clock

The clock used for the SpaceWire link receiver and transmitter logic is taken from the dedicated SpaceWire clock pin `SPW_CLK` either directly, or multiplied with a PLL, depending on the value of the configuration register for the SpaceWire clock mux and PLL. See chapter 10 for more information. It is possible to source the internal system clock using the `SPW_CLK` via the internal PLL, however, the system clock must at all times be supplied to the system via the `SYS_CLK`.

## 4.5 MIL-STD-1553B clock

The 20 MHz clock for the MIL-STD-1553B codec can be taken from the IO mux (GPIO 10, 47 or 61). The clock can also be sourced from `SYS_CLK`.

### 4.5.1 Using PLL clock as input clock for 1553B interface

The PLL output clock frequency can be used to generate a MIL-STD-1553B clock. The MIL-STD-1553B clock can be generated by dividing the PLL frequency by 20, see section 10 for details on the MIL-STD-1553B clock divisor registers.

## 4.6 PacketWire RX Clock

The external clock input for the PacketWire clock receiver is available via the IO mux, see section 2.5. For more information about the PacketWire see section 31.

The PacketWire RX clock can also be generated from internal PacketWire TX clock. The PacketWire TX clock is selected as input to the PacketWire RX clock when the PacketWire is deselected in the IO mux.

# LEON3FT Microcontroller

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## 4.7 ADC Clock

ADC clock shall match the sampling speed required by the application. Maximum sampling speed is 500 kSps i.e. maximum ADC clock frequency is 10 MHz. The ADC clock is configured via registers, see 12.

## 4.8 DAC Clock

DAC clock shall match the sampling speed required by the application. Maximum sampling speed is 25 MSps i.e. maximum DAC clock frequency is 25 MHz. The DAC clock is configured via registers, see 15.

## 4.9 Clock gating unit

The design has a clock gating unit through which individual cores can have their clocks enabled/disabled and resets driven.

The LEON3 processor core will automatically be clock gated when the processor enters power-down or halt state. The floating-point units (GRFPU) will be clock gated when the corresponding processor has disabled FPU operations by setting the %psr.ef bit to zero, or when the processor has entered power-down/halt mode.

For more information see the chapter about the clock gating unit section 27.

## 4.10 Debug AHB bus clocking

All cores on the Debug AHB bus will be gated off when the DSU\_EN signal is set to low.

## 4.11 PLL Lock and clock output

The internal PLL lock signal, SpW, MIL-1553, Scrubber and System clock can be driven out of the chip using GPIO pins for diagnostic purposes. Refer to table 71 for register enables.

# LEON3FT Microcontroller

## 5 Reset

The device has an on-chip reset generator that creates a reset signal that is fed to the rest of the system. The reset is asynchronously set and synchronously released after a delay. The delay can be controlled by connecting an external capacitance to the external pin C\_RST input.

All peripherals can be reset independently while the processor continues execution. Thus giving the option to force the full device into a known state during reset mode or just applying a hard reset to selected peripherals. Peripherals are reset independently via register accessible from the processor in the microcontroller or via remote accesses via UART, SPI, CAN-FD, MIL-STD-1553B or SpaceWire interface. Remote access via MIL-STD-1553B requires external boot ram. For more information about individual reset control see chapter 27.2.

The microcontroller includes a brown-out detector to supervise the external power supply for the system to shutdown in a controlled manner. A system shutdown is requested via an interrupt to the processor by the brown-out detector in case the supply voltage falls below a specific value. The voltage level is programmable and is always set to the lowest possible value by default after reset.

### 5.1 IO Reset

The 64 General purpose IO and LVDS described in chapter 2.4 and 2.5 will set to high impedance mode during power-up/down, Brown detection or if a failure has been detected in the IO configuration registers described in chapter 7.1.

Table 26: Digital IO reset state table

Name	Notes	Power-up/down state (TBD)	State after reset	Brown-Out Detection state (TBD)	Normal state
RESET_OUT_N <sup>1)</sup>		HiZ	Dig input	Low	Dig output 0
RESET_IN_N	Reset input override	Dig input	Dig input	Dig input	Dig input
XO_OUT	Digital clock output	Dig output	Dig output	Dig output	Dig output
SYS_CLK	System clock	Dig input	Dig input	Dig input	Dig input
SPW_CLK	SpaceWire clock	Dig input	Dig input	Dig input	Dig input
DSU_EN	Debug Support Unit enable signal	Dig input	Dig input	Dig input	Dig input
DSU_BREAK	Debug Support Unit break signal	Dig input	Dig input	Dig input	Dig input
DUART_TXD <sup>1)</sup>	Debug UART, transmit data	HiZ	Dig input	Dig output	Dig output
DUART_RXD	Debug UART, receive data	Dig input	Dig input	Dig input	Dig input
SPIM_MOSI <sup>1)</sup>	SPI Memory master output slave input	HiZ	Dig input	Dig output	Dig output
SPIM_SCK <sup>1)</sup>	SPI Memory master clock output	HiZ	Dig input	Dig output	Dig output
SPIM_SEL <sup>1)</sup>	SPI Memory slave select output	HiZ	Dig input	Dig output	Dig output
SPIM_MISO	SPI Memory master input slave output	Dig input	Dig input	Dig input	Dig input

# LEON3FT Microcontroller

Table 26: Digital IO reset state table

Name	Notes	Power-up/down state (TBD)	State after reset	Brown-Out Detection state (TBD)	Normal state
LVDS_RX[0]p	For functional pin description see section 2.5 and 58.2.	HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_RX[0]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_RX[1]p		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_RX[1]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_RX[2]p		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_RX[2]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[0]p		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[0]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[1]p		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[1]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[2]p		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[2]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[4]p		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[4]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[5]p		HiZ	HiZ	User defined <sup>2)</sup>	User defined
LVDS_TX[5]n		HiZ	HiZ	User defined <sup>2)</sup>	User defined
GPIO[0] <sup>1)</sup>	For functional pin description see section 2.5 and 58.2.	HiZ	Dig input	User defined <sup>2)</sup>	User defined
GPIO[1] <sup>1)</sup>		HiZ	Dig input	User defined <sup>2)</sup>	User defined
GPIO[2:14]		HiZ	HiZ	User defined <sup>2)</sup>	User defined
GPIO[15] <sup>1)</sup>		HiZ	Dig input	User defined <sup>2)</sup>	User defined
GPIO[16]		HiZ	HiZ	User defined <sup>2)</sup>	User defined
GPIO[17] <sup>1)</sup>		HiZ	Dig input	User defined <sup>2)</sup>	User defined
GPIO[18] <sup>1)</sup>		HiZ	Dig input	User defined <sup>2)</sup>	User defined
GPIO[19:61]		HiZ	HiZ	User defined <sup>2)</sup>	User defined
GPIO[62] <sup>1)</sup>		HiZ	Dig input	User defined <sup>2)</sup>	User defined
GPIO[63] <sup>1)</sup>		HiZ	Dig input	User defined <sup>2)</sup>	User defined
TESTEN	Test enable signal	Dig input	Dig input	Dig input	Dig input

Note 1: External pin should have an external pull-up/down to ground or supply

Note 2: Direction is locked for specific TBD during brown-out state to prevent IO contamination

# LEON3FT Microcontroller

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## 6 Technical notes

### 6.1 GRLIB AMBA plug&play scanning

The bus structure in this design requires some special consideration with regard to plug&play scanning. The default behavior of GRLIB AMBA plug&play scanning routines is to start scanning at address 0xFFFF0000. If any AHB/AHB bridges or APB bridges are detected during the scan, the general scanning routine traverses the bridge and reads the plug&play information from the bus behind the bridge. In this design, the default 0xFFFF0000 address gives plug&play information only for the Processor AHB bus. For the plug&play scanning routine to get plug&play information from all AHB buses the start address 0x9FFF0000 need to be used.

### 6.2 Software portability

#### 6.2.1 Instruction set architecture

The LEON3FT processor used in this design implements the SPARC V8 instruction set architecture. This means that any compiler that produces valid SPARC V8 executables can be used. Full instruction set compatibility is kept with LEON2FT and LEON3FT applications.

#### 6.2.2 Peripherals

Standard GRLIB software drivers can be used.

For software driver development, this document describes the capabilities offered by the LEON3FT microcontroller system. In order to write a generic driver for a GRLIB IP core, that can be used on all systems based on GRLIB, please also refer to the generic IP core documentation in GRLIB IP Core User's Manual [GRIP]. Note, however, that the generic documentation may describe functionality not present in this implementation and that this data sheet supersedes any documentation found in [GRIP] for this system.

#### 6.2.3 Plug and play

Standard GRLIB AMBA plug&play layout is used. The same software routines used for typical LEON/GRLIB systems can be used.

# LEON3FT Microcontroller

## 7 System Startup Status and General Configuration

This section describes general status register and control registers for LEON3FT microcontroller system. General status and configuration register described in this section are be used for IO function selection and peripheral configuration. GPIOs are sampled during RESET and stored in register for configuration of IO switch matrix and peripherals.

This section also describes how to get access to control signal to analog functions from external pins and how to enable memory build test and interrupt test.

### 7.1 Configuration Registers

The registers are mapped into AMBA address space. The register layout used for configuration of GPIO is explained in section 2.5.

System register bits affected by bootstraps are marked with a '\*' in reset value filed.

Table 27. System IO configuration register

AMBA address	Register	Acronym
0x8000D000	System IO configuration for GPIO 0 to 7	SYS.CFG.GP0
0x8000D004	System IO configuration for GPIO 8 to 15	SYS.CFG.GP1
0x8000D008	System IO configuration for GPIO 16 to 23	SYS.CFG.GP2
0x8000D00C	System IO configuration for GPIO 24 to 31	SYS.CFG.GP3
0x8000D010	System IO configuration for GPIO 32 to 39	SYS.CFG.GP4
0x8000D014	System IO configuration for GPIO 40 to 47	SYS.CFG.GP5
0x8000D018	System IO configuration for GPIO 48 to 55	SYS.CFG.GP6
0x8000D01C	System IO configuration for GPIO 56 to 63	SYS.CFG.GP7
0x8000D020	System IO Pullup configuration for GPIO 0 to 31	SYS.CFG.PULLUP0
0x8000D024	System IO Pullup configuration for GPIO 32 to 64	SYS.CFG.PULLUP1
0x8000D028	System IO Pulldown configuration for GPIO 0 to 31	SYS.CFG.PULLDOWN0
0x8000D02C	System IO Pulldown configuration for GPIO 32 to 64	SYS.CFG.PULLDOWN1
0x8000D030	LVDS configuration 0	SYS.CFG.LVDS0
0x8000D034	LVDS configuration 1	SYS.CFG.LVDS1
0x8000D038	System IO Schmitt trigger configuration for GPIO 0 to 31	SYS.CFG.SCHMITT0
0x8000D03C	System IO Schmitt trigger configuration for GPIO 32 to 64	SYS.CFG.SCHMITT1

Table 28. 0x8000D000 - SYS.CFG.GP0 - System GPIO configuration register0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0																																
GP7								GP6								GP5								GP4								GP3								GP2								GP1								GP0							
* 1)								* 1)								* 1)								* 1)								* 1)								* 1)								* 1)															
rw								rw								rw								rw								rw								rw								rw															

- 31: 28 GPIO7 functional select (GP7) - Select functionality for GPIO pin 7. For functionality see Table 7.
- 27: 24 GPIO6 functional select (GP6) - Select functionality for GPIO pin 6. For functionality see Table 7.
- 23: 20 GPIO5 functional select (GP5) - Select functionality for GPIO pin 5. For functionality see Table 7.
- 19: 16 GPIO4 functional select (GP4) - Select functionality for GPIO pin 4. For functionality see Table 7.
- 15: 12 GPIO3 functional select (GP3) - Select functionality for GPIO pin 3. For functionality see Table 7.
- 11: 8 GPIO2 functional select (GP2) - Select functionality for GPIO pin 2. For functionality see Table 7.
- 7: 4 GPIO1 functional select (GP1) - Select functionality for GPIO pin 1. For functionality see Table 7.
- 3: 0 GPIO0 functional select (GP0) - Select functionality for GPIO pin 0. For functionality see Table 7.

Note 1: Reset value is set by bootstrap, see section 2.7.

# LEON3FT Microcontroller

Table 29. 0x8000D004 - SYS.CFG.GP1 - System GPIO configuration register1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GP7				GP6				GP5				GP4				GP3				GP2				GP1				GP0			
* 1)				* 1)				* 1)				* 1)				* 1)				* 1)				* 1)							
rw				rw				rw				rw				rw				rw				rw							

- 31: 28 GPIO15 functional select (GP7) - Select functionality for GPIO pin 15. For functionality see Table 7.
- 27: 24 GPIO14 functional select (GP6) - Select functionality for GPIO pin 14. For functionality see Table 7.
- 23: 20 GPIO13 functional select (GP5) - Select functionality for GPIO pin 13. For functionality see Table 7.
- 19: 16 GPIO12 functional select (GP4) - Select functionality for GPIO pin 12. For functionality see Table 7.
- 15: 12 GPIO11 functional select (GP3) - Select functionality for GPIO pin 11. For functionality see Table 7.
- 11: 8 GPIO10 functional select (GP2) - Select functionality for GPIO pin 10. For functionality see Table 7.
- 7: 4 GPIO9 functional select (GP1) - Select functionality for GPIO pin 9. For functionality see Table 7.
- 3: 0 GPIO8 functional select (GP0) - Select functionality for GPIO pin 8. For functionality see Table 7.

Note 1: Reset value is set by bootstrap, see section 2.7.

Table 30. 0x8000D008 - SYS.CFG.GP2 - System GPIO configuration register2

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GP7				GP6				GP5				GP4				GP3				GP2				GP1				GP0			
0x0				0x0				0x0				0x0				0x0				0x0				* 1)				* 1)			
rw				rw				rw				rw				rw				rw				rw				rw			

- 31: 28 GPIO23 functional select (GP7) - Select functionality for GPIO pin 23. For functionality see Table 7.
- 27: 24 GPIO22 functional select (GP6) - Select functionality for GPIO pin 22. For functionality see Table 7.
- 23: 20 GPIO21 functional select (GP5) - Select functionality for GPIO pin 21. For functionality see Table 7.
- 19: 16 GPIO20 functional select (GP4) - Select functionality for GPIO pin 20. For functionality see Table 7.
- 15: 12 GPIO19 functional select (GP3) - Select functionality for GPIO pin 19. For functionality see Table 7.
- 11: 8 GPIO18 functional select (GP2) - Select functionality for GPIO pin 18. For functionality see Table 7.
- 7: 4 GPIO17 functional select (GP1) - Select functionality for GPIO pin 17. For functionality see Table 7.
- 3: 0 GPIO16 functional select (GP0) - Select functionality for GPIO pin 16. For functionality see Table 7.

Note 1: Reset value is set by bootstrap, see section 2.7.

Table 31. 0x8000D00C - SYS.CFG.GP3 - System GPIO configuration register 3

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GP7				GP6				GP5				GP4				GP3				GP2				GP1				GP0			
* 1)				* 1)				* 1)				* 1)				* 1)				* 1)				* 1)				0x0			
rw				rw				rw				rw				rw				rw				rw				rw			

- 31: 28 GPIO31 functional select (GP7) - Select functionality for GPIO pin 31. For functionality see Table 7.
- 27: 24 GPIO30 functional select (GP6) - Select functionality for GPIO pin 30. For functionality see Table 7.
- 23: 20 GPIO29 functional select (GP5) - Select functionality for GPIO pin 29. For functionality see Table 7.
- 19: 16 GPIO28 functional select (GP4) - Select functionality for GPIO pin 28. For functionality see Table 7.
- 15: 12 GPIO27 functional select (GP3) - Select functionality for GPIO pin 27. For functionality see Table 7.
- 11: 8 GPIO26 functional select (GP2) - Select functionality for GPIO pin 26. For functionality see Table 7.
- 7: 4 GPIO25 functional select (GP1) - Select functionality for GPIO pin 25. For functionality see Table 7.
- 3: 0 GPIO24 functional select (GP0) - Select functionality for GPIO pin 24. For functionality see Table 7.

Note 1: Reset value is set by bootstrap, see section 2.7.

# LEON3FT Microcontroller

Table 32. 0x8000D010 - SYS.CFG.GP4 - System GPIO configuration register 4

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GP7		GP6		GP5		GP4		GP3		GP2		GP1		GP0																	
0x0		0x0		0x0		* 1)		* 1)		* 1)		* 1)		* 1)																	
rw		rw		rw		rw		rw		rw		rw		rw																	

- 31: 28 GPIO39 functional select (GP7) - Select functionality for GPIO pin 39. For functionality see Table 7.
- 27: 24 GPIO38 functional select (GP6) - Select functionality for GPIO pin 38. For functionality see Table 7.
- 23: 20 GPIO37 functional select (GP5) - Select functionality for GPIO pin 37. For functionality see Table 7.
- 19: 16 GPIO36 functional select (GP4) - Select functionality for GPIO pin 36. For functionality see Table 7.
- 15: 12 GPIO35 functional select (GP3) - Select functionality for GPIO pin 35. For functionality see Table 7.
- 11: 8 GPIO34 functional select (GP2) - Select functionality for GPIO pin 34. For functionality see Table 7.
- 7: 4 GPIO33 functional select (GP1) - Select functionality for GPIO pin 33. For functionality see Table 7.
- 3: 0 GPIO32 functional select (GP0) - Select functionality for GPIO pin 32. For functionality see Table 7.

Note 1: Reset value is set by bootstrap, see section 2.7.

Table 33. 0x8000D014 - SYS.CFG.GP5 - System GPIO configuration register 5

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GP7		GP6		GP5		GP4		GP3		GP2		GP1		GP0																	
0x0		0x0		0x0		0x0		0x0		0x0		0x0		0x0																	
rw		rw		rw		rw		rw		rw		rw		rw																	

- 31: 28 GPIO47 functional select (GP7) - Select functionality for GPIO pin 47. For functionality see Table 7.
- 27: 24 GPIO46 functional select (GP6) - Select functionality for GPIO pin 46. For functionality see Table 7.
- 23: 20 GPIO45 functional select (GP5) - Select functionality for GPIO pin 45. For functionality see Table 7.
- 19: 16 GPIO44 functional select (GP4) - Select functionality for GPIO pin 44. For functionality see Table 7.
- 15: 12 GPIO43 functional select (GP3) - Select functionality for GPIO pin 43. For functionality see Table 7.
- 11: 8 GPIO42 functional select (GP2) - Select functionality for GPIO pin 42. For functionality see Table 7.
- 7: 4 GPIO41 functional select (GP1) - Select functionality for GPIO pin 41. For functionality see Table 7.
- 3: 0 GPIO40 functional select (GP0) - Select functionality for GPIO pin 40. For functionality see Table 7.

Table 34. 0x8000D018 - SYS.CFG.GP6 - System GPIO configuration register 6

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GP7		GP6		GP5		GP4		GP3		GP2		GP1		GP0																	
* 1)		* 1)		* 1)		0x0		0x0		* 1)		* 1)		0x0																	
rw		rw		rw		rw		rw		rw		rw		rw																	

- 31: 28 GPIO55 functional select (GP7) - Select functionality for GPIO pin 55. For functionality see Table 7.
- 27: 24 GPIO54 functional select (GP6) - Select functionality for GPIO pin 54. For functionality see Table 7.
- 23: 20 GPIO53 functional select (GP5) - Select functionality for GPIO pin 53. For functionality see Table 7.
- 19: 16 GPIO52 functional select (GP4) - Select functionality for GPIO pin 52. For functionality see Table 7.
- 15: 12 GPIO51 functional select (GP3) - Select functionality for GPIO pin 51. For functionality see Table 7.
- 11: 8 GPIO50 functional select (GP2) - Select functionality for GPIO pin 50. For functionality see Table 7.
- 7: 4 GPIO49 functional select (GP1) - Select functionality for GPIO pin 49. For functionality see Table 7.
- 3: 0 GPIO48 functional select (GP0) - Select functionality for GPIO pin 48. For functionality see Table 7.

Note 1: Reset value is set by bootstrap, see section 2.7.



# LEON3FT Microcontroller

Table 35. 0x8000D01C - SYS.CFG.GP7 - System GPIO configuration register 7

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
GP7				GP6				GP5				GP4				GP3				GP2				GP1				GP0			
0x0				0x0				0x0				0x0				0x0				0x0				* 1)							
rw				rw				rw				rw				rw				rw				rw							

- 31: 28 GPIO63 functional select (GP7) - Select functionality for GPIO pin 63. For functionality see Table 7.
- 27: 24 GPIO62 functional select (GP6) - Select functionality for GPIO pin 62. For functionality see Table 7.
- 23: 20 GPIO61 functional select (GP5) - Select functionality for GPIO pin 61. For functionality see Table 7.
- 19: 16 GPIO60 functional select (GP4) - Select functionality for GPIO pin 60. For functionality see Table 7.
- 15: 12 GPIO59 functional select (GP3) - Select functionality for GPIO pin 59. For functionality see Table 7.
- 11: 8 GPIO58 functional select (GP2) - Select functionality for GPIO pin 58. For functionality see Table 7.
- 7: 4 GPIO57 functional select (GP1) - Select functionality for GPIO pin 57. For functionality see Table 7.
- 3: 0 GPIO56 functional select (GP0) - Select functionality for GPIO pin 56. For functionality see Table 7.

Note 1: Reset value is set by bootstrap, see section 2.7.

Table 36. 0x8000D020 - SYS.CFG.PULLUP0 - System GPIO pullup configuration register for GPIO 0 to 31

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UP																															
0x00000000																															
rw																															

- 31: 0 Select and configure inputs using internal pullup resistor (PULLUP) - Bit  $n$  in the bitfield corresponds to GPIO  $n$ .

Table 37. 0x8000D024 - SYS.CFG.PULLUP1 - System GPIO pullup configuration register for GPIO 32 to 63

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UP																															
0x00000000																															
rw																															

- 31: 0 Select and configure inputs using internal pullup resistor (PULLUP) - Bit  $n$  in the bitfield corresponds to GPIO  $32+n$ .

Table 38. 0x8000D028 - SYS.CFG.PULLDOWN0 - System GPIO pulldown configuration register for GPIO 0 to 31

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DOWN																															
0x00000000																															
rw																															

- 31: 0 Select and configure inputs using internal pulldown resistor (DOWN) - Bit  $n$  in the bitfield corresponds to GPIO  $n$ .

Table 39. 0x8000D02C - SYS.CFG.PULLDOWN1 - System GPIO pulldown configuration register for GPIO 32 to 63

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DOWN																															
0x00000000																															
rw																															

- 31: 0 Select and configure inputs using internal pulldown resistor (DOWN) - Bit  $n$  in the bitfield corresponds to GPIO  $32+n$ .

# LEON3FT Microcontroller

Table 40. 0x8000D030 - SYS.CFG.LVDS0 - System LVDS configuration register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RX3				NA				RX2				RX1				RX0				TX2				TX1				TX0			
0x0				0x0				0x0				* 1)				* 1)				0x0				* 1)				* 1)			
rw				rw				rw				rw				rw				rw				rw							

31: 28 LVDS Receiver 3 (RX3) - Select functionality for LVDS receiver 3  
 0x8 - LVDS receiver disable

27: 24 NA  
 0x8 - LVDS transmitter disable

23: 20 LVDS Receiver 2 (RX2) - Select functionality for LVDS receiver 2  
 0x8 - LVDS receiver disable

19: 16 LVDS Receiver 1 (RX1) - Select functionality for LVDS receiver 1  
 0x8 - LVDS receiver disable

15: 12 LVDS Receiver 0 (RX0) - Select functionality for LVDS receiver 0  
 0x8 - LVDS receiver disable

11: 8 LVDS Transmitter 2 (TX2) - Select functionality for LVDS transmitter 2  
 0x1 - SPI for Space Slave MISO  
 0x2 - SPI Master MOSI  
 0x3 - SPI Slave MISO  
 0x4 - LVDS GP Out 2  
 0x8 - LVDS transmitter disable

7: 4 LVDS Transmitter 1 (TX1) - Select functionality for LVDS transmitter 1  
 0x0 - SpaceWire Strobe Transmission 0  
 0x2 - SPI Master  
 0x4 - LVDS GP Out 1  
 0x8 - LVDS transmitter disable

3: 0 LVDS Transmitter 0 (TX0) - Select functionality for LVDS transmitter 0  
 0x0 - SpaceWire Data Transmission 0  
 0x2 - SPI Master SCLK  
 0x4 - LVDS GP Out 0  
 0x8 - LVDS transmitter disable

Note 1: Transmitter configuration not listed will force the transmitter to output a logic '0'

Note 2: Reset value is set by bootstrap, see section 2.7.

The connections listed below are always active:

LVDS Receiver 0 -> SpaceWire Data Receiver 1, SPI for Space Slave SCLK, LVDS INPUT 0

LVDS Receiver 1 -> SpaceWire Data Receiver 0, SPI for Space Slave MOSI, LVDS INPUT 1

LVDS Receiver 2 -> SpaceWire Strobe Receiver 0, SPI for Space Slave Select, LVDS INPUT 2

LVDS Receiver 3 -> SpaceWire Strobe Receiver 1, LVDS INPUT 3

The connections listed below are active only if a GPIO is not employed for the relevant signal:

LVDS Receiver 0 -> SPI Master MISO, SPI Slave SCLK

LVDS Receiver 1 -> SPI Slave MOSI

LVDS Receiver 2 -> SPI Slave SEL

# LEON3FT Microcontroller

Table 41. 0x8000D034 - SYS.CFG.LVDS1 - System LVDS configuration register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Unused				Unused				Unused				Unused				REF		FS		TX5			TX4								
-				-				-				-				0x0		0x0		0x0			0x0								
0x0				0x0				0x0				0x0				rw		rw		rw			rw								

- 31: 28 Not used
- 27: 24 Not used
- 23: 20 Not used
- 19: 16 Not used
- 15: 12 LVDS Reference (REF) - Disable LVDS Reference
  - 15 - Not used
  - 14 - Power Down LVDS internal VFREF for TX number 3 to 4
  - 13 - Power Down LVDS internal VFREF for RX and TX number 0 to 2
  - 12 - Power Down LVDS internal IBIAS for RX and TX number 0 to 3
- 11: 8 LVDS Failsafe Disable (FS) - Disable LVDS FailSafe
  - 11 - Disable Fail-Safe for RX3
  - 10 - Disable Fail-Safe for RX2
  - 9 - Disable Fail-Safe for RX1
  - 8 - Disable Fail-Safe for RX0
- 7: 4 LVDS Transmitter 5 (TX5) - Select functionality for LVDS transmitter 5
  - 0x0 - SpaceWire Strobe Transmission 1
  - 0x4 - LVDS GP Out 4
  - 0x8 - LVDS transmitter disable
- 3: 0 LVDS Transmitter 4 (TX4) - Select functionality for LVDS transmitter 4
  - 0x0 - SpaceWire Data Transmission 1
  - 0x1 - SPI for Space Slave MISO
  - 0x2 - SPI Master MOSI
  - 0x3 - SPI Slave MISO
  - 0x4 - LVDS GP Out 3
  - 0x8 - LVDS transmitter disable

Note 1: Transmitter configuration not listed will force the transmitter to output a logic '0'  
 Note 2: Reset value is set by bootstrap, see section 2.7.

Table 42. 0x8000D038 - SYS.CFG.SCHMITT0 - System GPIO schmitt trigger configuration register for GPIO 0 to 31

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DOWN																															
0x00000000																															
rw																															

- 31: 0 Select and configure inputs using internal schmitt trigger - Bit  $n$  in the bitfield corresponds to GPIO  $n$ .

Table 43. 0x8000D03C - SYS.CFG.SCHMITT1 - System GPIO schmitt trigger configuration register for GPIO 32 to 63

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DOWN																															
0x00000000																															
rw																															

- 31: 0 Select and configure inputs using internal schmitt trigger - Bit  $n$  in the bitfield corresponds to GPIO  $32+n$ .

# LEON3FT Microcontroller

## 7.2 Bootstrap information register

The register shows the current status of the external boot strap configuration used. The register can be modified in order to trigger a reboot and re-configuration of the microcontroller using the internal on-chip boot ROM. The default settings after reset depends on the state of external bootstrap pins. See section 3.1 for details.

Table 44. Boot strap register

AMBA address	Register	Acronym
0x80008000	Internal boot ROM configuration register. Register gets default value from external bootstrap pins after reset.	SYS.CFG.BOOT

Table 45. 0x80008000 - SYS.CFG.BOOT - Internal boot ROM configuration register

31		30		29		28		27		26		25		24		21		20		16		15		14		13		12		10		9		8		5		4		2		1		0	
EM	DE	RE	BY	CB	RE	SEL		DIV		NB	NV	R	BN	C	REM		SRC		AS	CS																									
* 1)	* 1)	* 1)	* 1)	* 1)		* 1)		* 1)		1	1	0	* 1)	* 1)	* 1)		* 1)		* 1)	* 1)																									
rw	rw	rw	rw	rw		rw		rw		rw	rw	rw	rw	rw	rw		rw		rw	rw																									

- 31 Enable Memory test (set to zero for fast re-boot). The default setting is determined by GPIO[62].
- 30 Disable EDAC for external memory. The default setting is determined by GPIO[0].
- 29 Redundant memory available. The default setting is determined by GPIO[63].
- 28 Bypass of internal boot ROM. This will force the microcontroller to boot from external selected source. The default setting is determined by GPIO[17].
- 27: 26 CAN Bit Rate (CB[1:0]). The default setting is determined by GPIO[63] (CB[0]) and DUART\_TXD (CB[1]).
- 25 Remote boot mode. The default setting is determined by SPIM\_MOSI.
- 24: 21 PLL Divisor startup value
  - 0 - Input frequency to PLL is 50 MHz
  - 1 - Input frequency to PLL is 25 MHz
  - 2 - Input frequency to PLL is 20 MHz
  - 3 - Input frequency to PLL is 12.5 MHz
  - 4 - Input frequency to PLL is 10 MHz
  - 5 - Input frequency to PLL is 5 MHz

All other values assume input frequency is set to 50 MHz. The default setting is determined by GPIO[63] and DUART\_TX.
- 20: 16 SpaceWire clock divisor
 

The register field set the reset value of register RTR.IDIV in the SpaceWire router. This register controls the link-rate during initialization (all states up to and including the connecting-state). For more information see 33.2.21. The default setting is determined by GPIO[63] and DUART\_TX.
- 15 Boot from NVRAM when bit is to '0'. Only available in package option with embedded NVRAM. Pin strapped to '1' by default in package without NVRAM in package.
- 14 Internal NVRAM exists in package when bit is to '0'. Pin strapped to '1' by default in package without NVRAM in package.
- 13 Not used
- 12: 10 CAN-FD/I2C node ID (BN[2:0]). The default setting is determined by GPIO[0] (BN[0]), GPIO[62] (BN[1]) and GPIO[15] (BN[2]).
- 9 CAN remote boot mode. The default setting is determined by SPIM\_MOSI and GPIO[18].

# LEON3FT Microcontroller

Table 45. 0x80008000 - SYS.CFG.BOOT - Internal boot ROM configuration register

8:	5	<p>Enable remote access interface:</p> <p>0x0 - None</p> <p>0x1 - SpaceWire</p> <p>0x2 - SPI2AHB</p> <p>0x4 - I2C</p> <p>0x8 - UART</p> <p>0x9 - CAN</p> <p>All other values are reserved for future boot options.</p>
		<p>The default setting is determined by SPIM_MOSI, SPIM_SCK and SPIM_SEL.</p>
4:	2	<p>Select external memory to boot from</p> <p>0x0 - External SPI ROM</p> <p>0x1 - External SRAM/MRAM</p> <p>0x2 - External ROM/PROM/EEPROM</p> <p>0x3 - Reserved</p> <p>0x4 - Reserved for future boot options</p> <p>0x5 - Reserved for future boot options</p> <p>0x6 - Reserved for future boot options</p> <p>0x7 - Reserved for future boot options</p> <p>The default setting is determined by SPIM_MOSI, SPIM_SCK and SPIM_SEL.</p>
		<p>1: Configure boot ROM to check and use ASW container. The default setting is determined by DUART_TX.</p>
		<p>0: CAN Select (TBD). The default setting is determined by GPIO[1].</p>
		<p>Note 1: The default settings after reset depends on the state of external bootstrap pins. For more details about bootstrap pins and the boot modes they configure, see section 3.1.</p>

## 7.3 Special Configuration Registers

The special registers are used for getting access to special functions in the LEON3FT microcontroller.

Special functions accessible via special configuration registers:

- Make digital control and status signals for on-chip analog functionality available on the external general inputs and outputs.
- Enable and run Production test on individual embedded memories
- Trigger interrupt test
- Enable external voltage reference

### 7.3.1 On-chip analog functions

Access to digital control and status signals for integrated analog functionality. Access to control and status for individual analog functions can be configured in the register SYS.CFG.ANA1 and SYS.CFG.ANA2. Register described in this section is only available in debug mode. Please contact Frontgrade Gaisler support if for more information is needed.

Table 46. Analog access configuration register

AMBA address	Register	Acronym
0x94002000	Analog test bus 1 configuration	SYS.CFG.ANA1
0x94002004	Analog test bus 2 configuration	SYS.CFG.ANA2
0x94002008	Analog test bus 3 configuration	SYS.CFG.ANA3
0x9400200C	Analog test bus 4 configuration	SYS.CFG.ANA4
0x94002010	Analog test bus 5 configuration	SYS.CFG.ANA5
0x94002014	Analog test bus 6 configuration	SYS.CFG.ANA6
0x94002018	Analog test bus 7 configuration	SYS.CFG.ANA7
0x9400201C	Analog test bus 8 configuration	SYS.CFG.ANA8
0x94002020	Test configuration register	SYS.CFG.ANA9
0x94002024	Bypass test buffer configuration	SYS.CFG.ANA10
0x94002028	Test buffer enable register	SYS.CFG.ANA11
0x9400202C	Select internal comparator	SYS.CFG.ANA12

Table 47. 0x940020xx - SYS.CFG.ANAx - Analog test bus configuration registers

31	0
ANA1	
0x0	
rw	

31: 0 Contact support for information

### 7.3.2 Memory Test

All memory entities have a build-in test structure for automatic testing. The automatic testing is triggered from software and can only be enabled when the external DSU\_EN signal is high. The test is destructive and all memory contents will be overwritten.

The memory test algorithm used is a March C- (evolved March C). The advantage of using the March C- test algorithm is that the algorithm covers many faults models without knowing the internal structure or the layout of the memory. The covered fault models includes Stuck-At, Transition, Coupling, Neighborhood Sensitivity and Address decoding fault.

The disadvantage of using the March C- algorithm is that it is very time consuming due to its nature of checking bit by bit multiple times.

March C- algorithm implemented  $\{\uparrow(w0); \uparrow(r0, w1); \uparrow(r1, w0); \downarrow(r0, w1); \downarrow(r1, w0); \downarrow(r0)\}$

Notation of the algorithm:

- $\uparrow$  : address 0 bit 0 to address n-1 bit m
- $\downarrow$  : address n-1 bit m to address n bit 0
- w0 : write 0 to bit (memory cell) location
- w1 : write 1 to bit (memory cell) location
- r0 : read a bit (memory cell) value should be 0
- r1 : read a bit (memory cell) value should 1

# LEON3FT Microcontroller

The March C- test algorithm is enabled per memory instantiation by writing to the configuration register SYS.CFG:MEMTEST.

Table 48. Memory test configuration register

AMBA address	Register	Acronym
0x94003000	Configuration register for memory test 0	SYS.CFG.MEMTEST0
0x94003004	Configuration register for memory test 1	SYS.CFG.MEMTEST1
0x94003008	Configuration register for memory test 2	SYS.CFG.MEMTEST2
0x94003080	Status register for memory test 0	SYS.STS.MEMTEST0
0x94003084	Status register for memory test 1	SYS.STS.MEMTEST1
0x94003088	Status register for memory test 2	SYS.STS.MEMTEST2

Table 49. 0x90003000 - SYS.CFG.MEMTEST0 - Memory test configuration register0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DM	IM	DBG5	DBG4	DBG3	DBG2	DBG1	DBG0	DSU5	DSU4	DSU3	DSU2	DSU1	DSU0	RW1	RW0																
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0																
r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w																

- 31: 30 On-chip data memory test control bits (DM):
  - 0x0 - Not used (Memory bit for memory is kept in reset state)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Write 0x0 to all locations in memory
  - 0x3 - Not used
- 29: 28 On-chip Instruction memory test control bits (IM):
  - 0x0 - Not used (Memory bit for memory is kept in reset state)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Write 0x0 to all locations in memory
  - 0x3 - Not used
- 27: 26 Trace Memory on MAIN AHB bus (DBG0 - DBG5):
- 25: 24 0x0 - Not used (Memory bit for memory is kept in reset state)
- 23: 22 0x1 - Enable March C- test algorithm
- 21: 20 0x2 - Write 0x0 to all locations in memory
- 19: 18 0x3 - Not used
- 17: 16
- 15: 14 Trace Memory on MAIN AHB bus (DSU0 - DSU5):
- 13: 12 0x0 - Not used (Memory bit for memory is kept in reset state)
- 11: 10 0x1 - Enable March C- test algorithm
- 9: 8 0x2 - Write 0x0 to all locations in memory
- 7: 6 0x3 - Not used
- 5: 4
- 3: 2 LEON3FT register Window 1 memory (RW1):
  - 0x0 - Not used (Memory bit for memory is kept in reset state)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Write 0x0 to all locations in memory
  - 0x3 - Not used
- 1: 0 LEON3FT register Window 0 memory (RW0):
  - 0x0 - Not used (Memory bit for memory is kept in reset state)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Write 0x0 to all locations in memory
  - 0x3 - Not used

# LEON3FT Microcontroller

To minimize the power consumption all memory tests should be executed in sequence. It is still possible to execute all tests in parallel to shorten the test time. The run time is depended upon the number of memory cells in the memory entity. The largest memory entity's are the data (64KiB) and instruction memory (64KiB).

The results and current status can be read in the status register SYS.STAT:MEMTEST. The status register indicates if test is running and if any error was detected during the memory test per memory entity in the LEON3FT microcontroller.

Table 50. 0x94003080 - SYS.STAT.MEMTEST0 - Memory test status register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DM	IM	DBG5	DBG4	DBG3	DBG2	DBG1	DBG0	DSU5	DSU4	DSU3	DSU2	DSU1	DSU0	RW1	RW0																
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0																
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw																

- 31: 30 On-chip data memory test control bits (DM):
  - 0x0 - No error detected during last test (If test has been run)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Error during last scan
  - 0x3 - Invalid state and test result
- 29: 28 On-chip Instruction memory test control bits (IM):
  - 0x0 - No error detected during last test (If test has been run)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Error during last scan
  - 0x3 - Invalid state and test result
- 27: 26 Trace Memory on MAIN AHB bus (DBG0 - DBG5):
- 25: 24 0x0 - No error detected during last test (If test has been run)
- 23: 22 0x1 - Enable March C- test algorithm
- 21: 20 0x2 - Error during last scan
- 19: 18 0x3 - Invalid state and test result
- 17: 16
- 15: 14 Trace Memory on MAIN AHB bus (DSU0 - DSU5):
- 13: 12 0x0 - No error detected during last test (If test has been run)
- 11: 10 0x1 - Enable March C- test algorithm
- 9: 8 0x2 - Error during last scan
- 7: 6 0x3 - Invalid state and test result
- 5: 4
- 3: 2 LEON3FT register Window 1 memory (RW1):
  - 0x0 - No error detected during last test (If test has been run)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Error during last scan
  - 0x3 - Invalid state and test result
- 1: 0 LEON3FT register Window 0 memory (RW0):
  - 0x0 - No error detected during last test (If test has been run)
  - 0x1 - Enable March C- test algorithm
  - 0x2 - Error during last scan
  - 0x3 - Invalid state and test result

### 7.3.3 System configuration register

This register can be used to test system, change system error behavior or enable special system functions e.g. interface loopback functionality or to enable external voltage reference.



# LEON3FT Microcontroller

The interrupt test is accessible to the system in all functional modes. Protection scheme has been added to the interrupt test functionality in order to prevent erroneous accesses to the functionality. The generated interrupt event will be inserted into the interrupt controller and the intention is to test interrupt controller and interrupt software.

The interrupt test control register contains a interrupt number bit field and two protection bits. The two protection bits are used as protection and enable bits for the interrupt test. When the protection bits are toggled an interrupt event is asserted to the interrupt controller.

Table 51. Interrupt test configuration register

AMBA address	Register	Acronym
0x8000E000	Configuration register for memory test, LVDS reference and Main bus configuration	SYS.CFG.SCFG
0x94006000	DSU Break configuration	SYS.CFG.BREAKCFG
0x94007000	DSU Break enable	SYS.CFG.BREAKEN

Table 52. 0x8000E000 - SYS.CFG.SCFG - Interrupt test configuration register

31	29	28	27	23	22	21	20	18	17	16	15	14	13	12	11	10	9	8	3	2	1	0
R	DI	TIOSEL			MD	MO	VREF		SPW	LL	LS	LE	FS	PR	IRQ			MR	WE	EE		
0x0	0x0	0x0			0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r	rw	rw			rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

- 31: 29 Not used
- 28 DAC production test input
- 27: 23 Analog production test output
- 22 Internal memory IO direction
- 21 Override internal memory IO direction
- 20: 18 Enable and control of external voltage reference
  - Bit #20 - Enable external voltage reference
  - Bit #19 - Input external voltage reference (Only for test purpose during production)
  - Bit #18 - Bypass buffer, this bit should normally be set to 0 in order to get a full scale ADC reference output.
 To enable and output a reference for precision measurements using internal ADC set VREF bits to 100b.
- 17: 16 SpaceWire Loop-back control (SPW) - Control of SpaceWire loop-back production test.
  - Bit #17 - Enable internal loop-back for SpaceWire PHY 0 (LVDS)
  - Bit #16 - Enable internal loop-back for SpaceWire PHY 1 (CMOS)
 Internal loop-back means that the ports internal data and strobe signals are not mapped to the corresponding external SpaceWire I/O pins. They are instead routed back to the port internally (transmit data to receive data, transmit strobe to receive strobe).
- 15 LVDS External Loop (LL) - Enable LVDS external loop-back.
  - External loop-back means that the external LVDS I/O pins are not routed to the corresponding port. Instead they are routed back out on the external pins (LVDS\_RXp/n to LVDS\_TXp/n). Enable of external loop-back forces the LVDS receiver and transmitter to be enabled.
  - LVDS external loop-back mode enables external test of voltage input and low level detection.

# LEON3FT Microcontroller

Table 52. 0x8000E000 - SYS.CFG.SCFG - Interrupt test configuration register

- 14: 13 SpaceWire External Loop (LS) - SpaceWire external loop-back
  - 0x0 - Normal operation
  - 0x1 - External loop-back mode routed back via rising edge clocked flip-flops
  - 0x2 - External loop-back mode routed back via falling edge clocked flip-flops
  - 0x3 - External loop-back mode routed back via rising or falling edge clocked flip-flops

SpaceWire External loop-back means that the external SpaceWire I/O pins are routed via SpaceWire-Phy to the corresponding port. Pins are routed back via SpaceWire-Phy out on the external pins (SPW\_RXDp/n to SPW\_TXDp/n and SPW\_RXSp/n to SPW\_TXSp/n).

Test option 0x1 and 0x2 are used for setup and hold measurements for respective clock edge. Test option 0x3 is used for minimum pulse width detection.
- 12 Locken (LE) - Support Locked transfers in SCRUBBER.
- 11 Force Scrubber (FS) - Force Scrubber to function as AHBSTAT unit on main AMBA bus.
- 10: 9 Interrupt test protection bits (PROT) - Protection and generation of interrupt test for specified interrupt source.
 

The protection bits needs to be toggled in-order to generate a test interrupt i.e.both PROT bits needs to be read and bitwise inverted before written back to the PROT bit-field to generate a interrupt.
- 8:3 Interrupt source (IRQ) - An event will be generated on the interrupt source
- 2 MIL-1553B reset disable (MR) - Disable reset signal from MIL-1553B core
- 1 Override watchdog error generation (WE) - Disables reset request. To be used during debug of the system
- 0 Override error generation (EE) - Disables reset generation when processor error is detected. To be used during debug of the system

Table 53. 0x94006000 - SYS.CFG.BREAKCFG - DSU Break configuration

31	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	R1R	R0R	R	R	R1R0	R1UC	R	R0R1	R	R0UC	R	UCR1	UCR0	R	
0x0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

- 31: 14 Reserved
- 13 RTA1 Power down after reset (R1R)
- 12 RTA0 Power down after reset (R0R)
- 11 Reserved
- 10 Reserved
- 9 Break RTA1 on RTA0 (R1R0)
- 8 Break RTA1 on LEON3FT (R1UC)
- 7 Reserved
- 6 Break RTA0 on RTA1 (R0R1)
- 5 Reserved
- 4 Break RTA0 on LEON3FT (R0UC)
- 3 Reserved
- 2 Break LEON3FT on RTA1 (UCR1)
- 1 Break LEON3FT on RTA0 (UCR0)
- 0 Reserved

Table 54. 0x94007000 - SYS.CFG.BREAKEN - DSU Break enable

31	6	5	4	3	2	1	0
R	RC1	RC0	UC	RB1	RB0	UB	
0x0	0	0	0	0	0	0	0
r	rw	rw	rw	rw	rw	rw	rw

# LEON3FT Microcontroller

Table 54. 0x94007000 - SYS.CFG.BREAKEN - DSU Break enable

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31: 6	Reserved
5	RTA1 Microcontroller Clear Now (RC1)
4	RTA0 Microcontroller Clear Now (RC0)
3	LEON3FT Microcontroller Clear Now (UC)
2	RTA1 Microcontroller Break Now (RB1)
1	RTA0 Microcontroller Break Now (RB0)
0	LEON3FT Microcontroller Break Now (UB)

# LEON3FT Microcontroller

## 8 Reset Generation and Brownout Detection

### 8.1 Overview

The Reset Generation and Brownout detection provides the system with a reset signal, deterministic startup behavior during power-on of the system and detection of power supply failure on board level.

The generated reset is output on a 3.3V IO to be used in the system.

### 8.2 Operation

#### 8.2.1 System overview

The Reset generation and Brownout detection consists of two analog functions: The Power On Reset (POR) and the Brownout detection (BO).

The Brownout detectors will monitor the 1.8V and all 3.3V supplies. At the event of crossing a Brownout threshold, an interrupt will be generated. When such an interrupt is detected, the software needs to take action, typically shutting down critical parts of the system in a well controlled way. The time from detection of supply brownout to activation of system reset is determined by the external power supplies capability to maintain the supply voltages (the amount of decoupling capacitance on PCB).

#### 8.2.2 Detailed description

An internal reset signal is generated from level detection of the core supply voltage, VDD\_CORE. When this supply is below the detector threshold, the internal reset signal is low. When the supply goes above the threshold, the internal reset is still kept low until the reset release time has passed, then, it goes high.

The internal system reset is also activated on activation of MIL-STD-1553B triggered reset, watchdog event, or error event.

Watchdog event: Watch dog timer unit drives a signal to request restart of the system. Watch dog functionality is described in section 35. User can override reset request with control register described in section 7.3.3.

Error event: Processor error event drives a signal to request restart of the system. User can override reset request with control register described in section 7.3.3.

MIL-STD-1553B triggered reset: Using the mode command “Reset remote terminal” reset of the system can be activated. To enable this functionality refer section 24 which describes the MIL-STD-1553B interface, section 24.5.3 describes the respective mode code. User can override reset request with control register described in section 7.3.3.

There is an external input reset signal, RESET\_IN\_N, which in parallel with POR\_INT\_N generates a reset. This reset cycle includes a full reset release time delay before the internal reset is released. This delay is configurable by external capacitor C\_RST, see section 57.11 for electrical characteristics.

The internal reset signal and the external reset input signal RESET\_IN\_N input are asynchronous. However, note that the reset of all internal Microcontroller logic is synchronous with the system clock. Therefore, a positive edge on this clock is required after the internal reset is activated (after it goes low), for the reset to start taking effect on the internal Microcontroller logic, and to complete the internal Microcontroller reset state, 30 clock cycles are needed.

The RESET\_OUT\_N output is a buffered copy of the internal reset signal, see section 58.2 for electrical characteristics.

The Brownout detector on the supplies, VDD\_CORE, VDD\_IO, VDDA\_PLL, VDDA\_ADC, VDDA\_DAC, VDD\_LVDS, VDDA\_REF, have individually programmable threshold levels. The threshold selected for each supply must, in worst case, be set below the guaranteed minimum supply

# LEON3FT Microcontroller

voltage instant peak level provided on the package pins for each supply, respectively. Otherwise, undesired Brownout detections giving inadvertent system shutdowns can result, see section 57.11 for electrical characteristics.

Furthermore, for any supply voltage in the system that is equipped with a reset threshold detection, such as the on-chip VDD\_CORE detector or any arbitrary supply detector on PCB, the Brownout level must be set with a certain margin higher than the reset level, such that there is enough time to ensure that the Brownout interrupt routine can be executed before the reset is activated. Therefore, the selection of the Brownout threshold levels should be extra carefully co-designed with the power-supply and reset designs on PCB, in Microcontroller applications that will utilize the Brownout detectors on supply voltages that are also reset detected (which the VDD\_CORE always is).

The Brownout detection is latched in the interrupt handling logic, and the detected event can then be taken care of by the interrupt service routine.

After power-on reset, the Microcontroller starts with all Brownout interrupt mask bits set to enable.

## 8.2.3 Reset IO control

The 64 General purpose IO described in chapter 2.4 and 2.5 is forced to high impedance mode when core voltage supply goes below the reset ramp down threshold, see section 57.11 for electrical characteristics.

## 8.2.4 Brownout IO control

TBD

## 8.2.5 Access control

The reset release time is programmable by an external capacitor, C\_RST. Capacitor value and release time is specified in section 57.11

Brown Out detection level and interrupt generation can be controlled via registers.

## 8.3 Registers

The Reset Generation and Brownout Detection is programmed through registers mapped into APB address space.

Table 55. Reset Generation and Brownout Detection status and control registers

APB address offset	Register
0x00	Configuration register
0x04	Status register
0x08	Interrupt register
0x0C	Interrupt mask register
0x10	LDO trim register
0x14	Voltage monitor delay register
0x18	Voltage monitor powerdown register
0x1C	Unused
0x20	Power control, XO and LVDS driver enable register
0x24	Brown Out disable IO from local register

# LEON3FT Microcontroller

Table 56. 0x00 - CFG - Reset Generation and Brownout Detection Configuration register

31	30	29	28	27	26	25	24	23	22	21	20	18	17	15	14	12	11	9	8	6	5	3	2	0
R												BLI	BLC	BLA	BLD	BLB	BLL	BLP						
0												b000	b000	b000	b000	b000	b000	b000						
												rw	rw	rw	rw	rw	rw	rw						

- 31: 21 Reserved
- 20: 18 Brown Out Level for 3.3 V power supply (BLI)
- 17: 15 Brown Out Level for 1.8 V power supply (BLC)
- 14: 12 Brown Out Level for Analog ADC supply (BLA)
- 11: 9 Brown Out Level for Analog DAC supply (BLD)
- 8: 6 Brown Out Level for BandGap supply (BLB)
- 5: 3 Brown Out Level for LVDS power supply (BLL)
- 2: 0 Brown Out Level for PLL power supply (BLP)

000 sets the minimum value for the threshold, 111 the maximum

Table 57. 0x04 - STS - Reset Generation and Brownout Detection status register

31	RESERVED							6	5	4	3	2	1	0
							BI	BC	BA	BD	BB	BL	BP	
							0	0	0	0	0	0	0	
							r	r	r	r	r	r	r	

- 31: 7 RESERVED
- 6 Brown Out Detected (BI) - Faulty 3.3 V power supply detected
- 5 Brown Out Detected (BC) - Faulty 1.8 V power supply detected
- 4 Brown Out Detected (BA) - Faulty ADC power supply
- 3 Brown Out Detected (BD) - Faulty DAC power supply
- 2 Brown Out Detected (BB) - Faulty BandGap power supply
- 1 Brown Out Detected (BL) - Faulty LVDS power supply detected
- 0 Brown Out Detected (BP) - Faulty PLL power supply detected

Table 58. 0x08 - IRQ - Reset Generation and Brownout Detection Interrupt Flags

31	RESERVED							6	5	4	3	2	1	0
							II	IB	ID	IA	IC	IL	IR	
							0	0	0	0	0	0	0	
							wc	wc	wc	wc	wc	wc	wc	

- 31: 7 RESERVED
- 6 Interrupt Flag for Brown Out Detection (II)
- 5 Interrupt Flag for Brown Out Detection (IC)
- 4 Interrupt Flag for Brown Out Detection (IA)
- 3 Interrupt Flag for Brown Out Detection (ID)
- 2 Interrupt Flag for Brown Out Detection (IB)
- 1 Interrupt Flag for Brown Out Detection (IL)
- 0 Interrupt Flag for Brown Out Detection (IP)

# LEON3FT Microcontroller

Table 59. 0x0C - MSK - Reset Generation and Brownout Detection Interrupt Mask

31		6	5	4	3	2	1	0
	RESERVED	MI	MB	MD	MA	MC	ML	MR
	0x00000000	0	0	0	0	0	0	0
	r	rw	rw	rw	rw	rw	rw	rw

- 31: 7 RESERVED
- 6 Interrupt Mask for Brown Out Detection (MI) - Set to 0 to mask interrupt generation for 3.3V power supply detection interrupt from Brown Out detection
- 5 Interrupt Mask for Brown Out Detection (MC) - Set to 0 to mask interrupt generation for 1.8 V power supply detection interrupt from Brown Out detection
- 4 Interrupt Mask for Brown Out Detection (MA) - Set to 0 to mask interrupt generation for ADC power supply detection interrupt from Brown Out detection
- 3 Interrupt Mask for Brown Out Detection (MD) - Set to 0 to mask interrupt generation for DAC power supply detection interrupt from Brown Out detection
- 2 Interrupt Mask for Brown Out Detection (MB) - Set to 0 to mask interrupt generation for faulty BandGap power supply detection interrupt from Brown Out detection
- 1 Interrupt Mask for Brown Out Detection (ML) - Set to 0 to mask interrupt generation for faulty LVDS power supply detection interrupt from Brown Out detection
- 0 Interrupt Mask for Brown Out Detection (MP) - Set to 0 to mask interrupt generation for faulty PLL power supply detection interrupt from Brown Out detection

Table 60. 0x10 - LDOTRM - LDO Trimmer

31		3	2	0
	RESERVED			TRM
	0			b011
	r			rw

- 31: 3 RESERVED
- 0: 2 LDO trimmer value (TRM):
  - b000 -> 0mV
  - b001 -> +22mV
  - b010 -> +44mV
  - b011 -> +66mV (Default)
  - b100 -> -88mV
  - b101 -> -66mV
  - b110 -> -44mV
  - b111 -> -22mV

Table 61. 0x14 - VDEL - Voltage monitor delay register

31		14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	R	BDI	BDC	BDA	BDD	BDB	BDL	BDP								
	0	b00	b00	b00	b00	b00	b00	b00								
		rw	rw	rw	rw	rw	rw	rw								

- 31: 14 Reserved
- 13: 12 Brown Out Delay for 3.3 V power supply (BDI)
- 11: 10 Brown Out Delay for 1.8 V power supply (BDC)
- 9: 8 Brown Out Delay for Analog ADC supply (BDA)
- 7: 6 Brown Out Delay for Analog DAC supply (BDD)

# LEON3FT Microcontroller

Table 61. 0x14 - VDEL - Voltage monitor delay register

- 5: 4 Brown Out Delay for BandGap supply (BDB)
- 3: 2 Brown Out Delay for LVDS power supply (BDL)
- 1: 0 Brown Out Delay for PLL power supply (BDP)

Table 62. 0x18 - VPD - Voltage monitor powerdown register

31		6	5	4	3	2	1	0
	RESERVED	BI	BC	BA	BD	BB	BL	BP
	0x00000000	0	0	0	0	0	0	0
	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w

- 31: 7 RESERVED
- 6 Brown Out Powerdown (BI) - Powerdown 3.3 V power supply detected
- 5 Brown Out Powerdown (BC) - Powerdown 1.8 V power supply detected
- 4 Brown Out Powerdown (BA) - Powerdown ADC power supply
- 3 Brown Out Powerdown (BD) - Powerdown DAC power supply
- 2 Brown Out Powerdown (BB) - Powerdown BandGap power supply
- 1 Brown Out Powerdown (BL) - Powerdown LVDS power supply detected
- 0 Brown Out Powerdown (BP) - Powerdown PLL power supply detected

Table 63. 0x20 - XEN - Power control, XO and LVDS driver enable register

31		3	2	1	0
	RESERVED	LP	PP	XP	
	0x00000000	0	0	0	
	r	r/w	r/w	r/w	

- 31: 3 RESERVED
- 2 Power down LVDS (LP) - Power down LVDS power supply
- 1 Power down POR (PP) - Power Down POR power supply
- 0 Power down XO (XP) - Power down XO power supply

Note: Register is protected by password. Contact [support@gaisler.com](mailto:support@gaisler.com)

Table 64. 0x24 - BDI - Brown Out disable IO from local register

31		1	0
	RESERVED	D	
	0x00000000	0	
	r	r/w	

- 31: 2 RESERVED
- 0 Disable IO (D) - Brown Out disable IO from local register

Note: Register is protected by password. Contact [support@gaisler.com](mailto:support@gaisler.com)



# LEON3FT Microcontroller

## 9 Crystal Oscillator (XO)

### 9.1 Overview

The internal crystal oscillator (XO) contains all *active* oscillator parts, and a crystal (XTAL) is added on PCB on XO\_X1 and XO\_X2 pins. The clock output pin, XO\_OUT, provides a CMOS square-wave output signal.

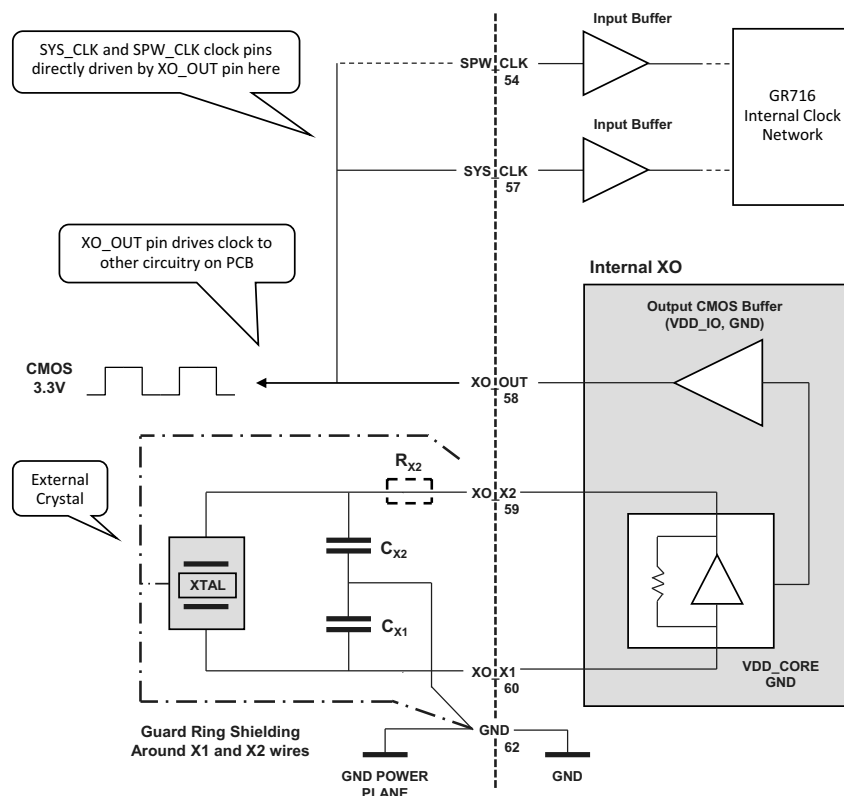


Figure 17. Connection diagram how to use the internal crystal oscillator (XO) as GR716 clock source.

## 9.2 Operation

### 9.2.1 System overview

The internal XO implementation supports a general class of crystals, see the following sections. Based on the selected crystal, an accurate and stable frequency is provided on the oscillator output, XO\_OUT, which can be directly connected to the GR716 clock inputs. This output clock signal can also be used to other circuitry on PCB, and in case of driving an impedance matched clock net on PCB, e.g. 50Ω, it is recommended to add a clock driver buffer on PCB with adequate drive capability.

### 9.2.2 Detailed description

The internal XO is supplied by the microcontroller internal core supply,  $V_{DD\_CORE}$ , and the oscillator output is available on an external pin, XO\_OUT (CMOS), supplied by  $V_{DD\_IO}$ . The external crystal, to be connected to the XO pins (XO\_X1 and XO\_X2), should be a parallel-resonant fundamental-tone AT-cut crystal. Also a load capacitor to ground on each of these two pins are required on PCB. See the following sections for functional crystal configurations and PCB detailed implementation of the XO interface.

The range of supported frequencies is 5-25 MHz, where down to 5MHz would be recommended in applications where the XO power consumption itself is required to be low (<1mA). Special applica-

# LEON3FT Microcontroller

tion cases, which need a low-noise clock directly connected from XO\_OUT to the application circuitry on PCB, may need the XO to run at a specific frequency for the application, e.g., the analog precision PWM application, APWM\_DAC, in chapter 55. In general, any XO frequency within 5-25 MHz can be implemented with the internal XO, and the internal PLL supports five discrete input frequencies across this range, and generates higher internal clock frequencies than 25MHz to be used in GR716 clock configurations internally.

Typical start-up times for XO\_OUT, after  $V_{DD\_CORE}$  is within recommended operating conditions, is in the order of 1ms, and can spread from about 0.2-5 ms for the different crystal configuration examples in table 65. All of these crystal configurations start within 15ms under all operational conditions.

Current consumption for the internal XO is typically 0.5-3 mA, for these different crystal configuration examples. Temporary current during XO start-up is typically 10mA (max 20mA), and does not depend strongly on crystal configuration. In cases where PCB applications require low noise clock directly from XO\_OUT, it is recommended to design and decouple the XO supply voltage,  $V_{DD\_CORE}$ , to have maximum ripple voltage of about  $20mV_{p-p}$ .

In special applications where the internal XO needs to be replaced by an external, extremely good oscillator such as TCXO or even OCXO, a 3.3V CMOS compatible oscillator signal needs to be provided to the clock input(s) of GR716. To minimize the internal XO current consumption when it is not used, a detector is build-in to shut it down when both XO pins (XO\_X1 and XO\_X2) are pulled to ground via 10k $\Omega$  each.

## 9.2.3 Crystal recommendations and examples

This section presents general properties for a crystal (XTAL) to function properly with the internal XO, and a number of crystal configuration examples are listed in the following table.

The frequency of the crystal can be any value from 5-25 MHz. To work as input frequency to the internal PLL, it needs to be 5, 10, 12.5, 20 or 25 MHz, see chapter 10. Furthermore, it always needs to be of the type *parallel-resonant fundamental-tone AT-cut* crystal.

General recommendations for ESR in the crystal, in combination with  $C_{X1}$  and  $C_{X2}$  (ceramic NP0 or equivalent), at 25MHz, to guarantee XO oscillation:

- Minimum  $C_{X1}$  and  $C_{X2}$  is always 10 pF<sub>nom</sub>
- Maximum  $C_{X1}$  and  $C_{X2}$  is 22 pF<sub>nom</sub>, for worst-case maximum ESR of 100  $\Omega$
- Maximum  $C_{X1}$  and  $C_{X2}$  is 33 pF<sub>nom</sub>, for worst-case maximum ESR of 50  $\Omega$
- Maximum  $C_{X1}$  and  $C_{X2}$  is 47 pF<sub>nom</sub>, for worst-case maximum ESR of 30  $\Omega$

A tolerance of 20% on the above nominal capacitance values, and up to 10pF PCB parasitic capacitance per wire to ground, is taken into account for guaranteed oscillation. If the PCB parasitic capacitance is significantly larger than 10pF, the  $C_{X1}$  and  $C_{X2}$  values are to be decreased accordingly. Lower frequency than 25MHz allows for higher crystal ESR<sub>Max</sub> limit, where half the frequency will allow double the ESR<sub>Max</sub> limit.

Table 65. GR716 crystal configuration examples.

Crystal (XTAL)	Frequency [MHz]	Max ESR [ $\Omega$ ]	Load cap (diff.) <sup>1)</sup> [pF]	Nominal $C_{X1}$ & $C_{X2}$ <sup>1)</sup> [pF]
HC49US / U-Sxxx (Citizen)	5	150 , at 25°C	20	33
	25	50 , at 25°C	15	22
ABxxx (Abracon)	10	50 , at 25°C	18	33
	25	50 , at 25°C	18	22
JXS32-WA (Jauch)	20	45 , at 25°C	10	15
T1507 ESCC 3501/019 (Rakon)	5 <sup>2)</sup>	25 , full temp.	30	47
	10	25 , full temp.	30	47
T807 ESCC 3501/018 (Rakon)	20	25 , full temp.	30	47
	25 <sup>3)</sup>	25 , full temp.	30	47

Note 1: The load capacitance for a crystal is defined to be the differential capacitance that shall be connected between the two crystal terminals on PCB, for the crystal to oscillate correctly at its specified frequency. The total load capacitance is formed by  $C_{X1}$  &  $C_{X2}$ , the PCB stray capacitance, and the input capacitance of the XO\_X1 & XO\_X2 pins. Each XO pin has typically 4pF to ground. E.g., a crystal that needs a load capacitance of 20pF, where the PCB stray capacitance is 3pF per wire, will give  $C_{X1}=C_{X2} = 2 \times C_{Load,diff} - 4pF - 3pF = 33pF_{typ}$ .

Note 2: Example of crystal specification: Rakon STC5856, ESCC3501/019 C0164, for -40 to 95 °C

Note 3: Example of crystal specification: Rakon STC6131, ESCC3501/018 C0318, for -40 to 95 °C

In some crystal configuration cases, where the ESR is order(s) of magnitude lower than the guaranteed maximum limit for oscillation presented above, the oscillation amplitude can become too large from voltage stress point of view on the XO pins (XO\_X1 and XO\_X2). If the oscillation voltage peaks go outside any of the supply rails in worst-case conditions, the device long-term reliability cannot be guaranteed. Therefore, when the oscillation amplitude is higher than about  $0.9V_{pk-to-pk}$  on XO\_X1 in room temperature, such a crystal configuration needs a resistor,  $R_{X2}$ , inserted in-between XO\_X2 and  $C_{X2}$ , with a value commonly in the order of 0.1-1 k $\Omega$ . Either a trim-potentiometer can be inserted temporarily, or a fixed resistor with first trial value of 100 $\Omega$  can be inserted in the  $R_{X2}$  position. This value is increased, e.g., in steps of about 100 $\Omega$ , until the AC voltage on XO\_X1 pin decreases below  $0.9V_{pk-to-pk}$  typically in room temperature.

For the oscilloscope measurement to not load the XO\_X1 node noticeably, which could affect the measured amplitude, this measurement needs to be done with a low-capacitance active probe (ca 2pF). Alternatively, it can be done by a temporary capacitive divider, e.g., by inserting a large capacitance,  $C_{Large}$  (ca 100-300 pF), in series with the ground connection of  $C_{X1}$ . Then, a standard oscilloscope probe (ca 20pF) can be used to measure across  $C_{Large}$ , and the measured amplitude can be recalculated according to the division factor resulting from  $C_{Large}$  and  $C_{X1}$ .

### 9.2.4 PCB design considerations

This section lists PCB layout considerations how to connect the external components, see figure 18:

- Place  $C_{X1}$  *very close* to XO\_X1 pin, and connect ground by a wire to GND pin 62 (connect by individual via to pin 62), see figure 17. In addition to acting crystal load capacitance,  $C_{X1}$  will also act as low-pass filter for this XO input for any external disturbances onto the X1 wire (which may have to be rather long in some layout implementations depending on where the crystal needs to be placed).
- Place  $C_{X2}$  close to XO\_X2 pin, and connect ground by a wire to GND pin 62 (use same via to pin 62 as for  $C_{X1}$ ), or connect the wire to  $C_{X1}$  ground terminal. If series resistor,  $R_{X2}$ , is to be used it is placed close to XO\_X2 pin, and  $C_{X2}$  is placed close to  $R_{X2}$ .
- Place the crystal as close to XO\_X1 and XO\_X2 pins as feasible. However, the crystal may have placement requirements from mechanics point of view, which may have to take priority due to vibration requirements, etc. Anyhow, the crystal must be placed over the same PCB ground plane as used for GR716 GND, to be able to fulfill the guard ring requirements below.
- Route no longer signal traces than necessary from crystal to XO\_X1 and XO\_X2 pins. Use GND shielding all the way around these two wires (GND guard ring on both sides, above and under each wire), to suppress crosstalk in-between XO\_X1 and XO\_X2. Crosstalk to XO\_OUT and other PCB nets shall also be suppressed. In general, parasitic capacitance from XO\_X1 or XO\_X2 to any PCB net other than GND must be avoided in XO layout implementations. Since parasitic capacitance to GND can be compensated by decreasing the value of  $C_{X1}$  and  $C_{X2}$ , it is not harmful at all, as long as this segment of the GND net is *not electrically disturbed*. However, it should be noted that the oscillation frequency may be slightly shifted from the nominal frequency specified for the crystal, due to the significant inductance in the long wires.
- To avoid problems with electrically disturbed GND net, e.g., high supply currents flowing through the GND plane causing AC magnetic-field disturbance onto the X1 and X2 wires, the whole guard ring layout implementation needs to be GND partial planes/wires that are cut out from the general GND plane(s) in the PCB. Moreover, this whole guard ring implementation should be grounded in one single layout point, which should be GND pin 62 (use same via to pin 62 as for  $C_{X1}$ ), or connect to  $C_{X1}$  or  $C_{X2}$  ground terminal.

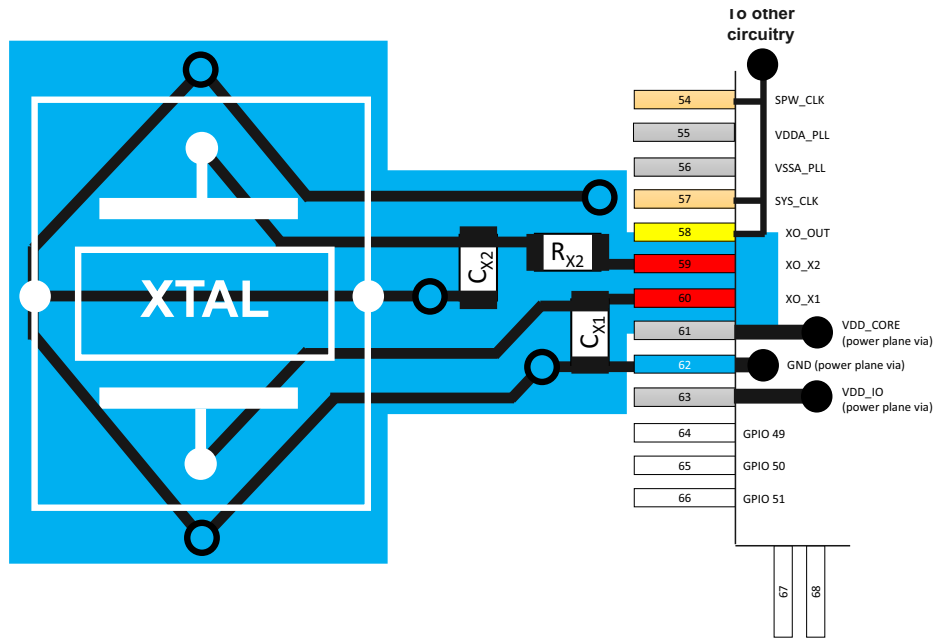


Figure 18. Example of recommended PCB layout

When the crystal is placed as close to the microcontroller as in figure 18, the black wires to the crystal (XTAL) can be routed all the way in the PCB *top* layer. Then, the blue plane, only grounded through pin 62 (also blue), is a cut-out ground plane in the layer directly under the black wire layer. When the crystal needs to be placed further away, the black wires should be routed in a PCB *inner* layer (vias placed directly to the left of  $C_{X1}$  and  $C_{X2}$ ). Then, the blue ground plane shape should be put in two layers, directly under and above the black wire layer. But keep in mind that the nominal oscillation frequency may be slightly shifted when these wires become long.

### 9.2.5 Access control

N/A

# LEON3FT Microcontroller

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## 10 PLL

### 10.1 Overview

The Phase-Lock-Loop (PLL) is capable of generating an phase locked output clock of 400MHz to the system. The input reference clock is multiplied by 2, 4, 8, 16, 20, 32, 40 or 80.

### 10.2 Operation

#### 10.2.1 System overview

The PLL provides a 400MHz internal clock, typically used as SpaceWire clock, etc. The PLL reference-clock input is a 3.3V CMOS input, to which the XO-oscillator clock output can be directly connected, or any other clock signal generated on PCB fulfilling the electrical specification of this input. The PLL reference-clock input is allowed to be asynchronous to any other clocks in the GR716B microcontroller.

#### 10.2.2 Detailed description

For more information about using the PLL in the system see section 4.

#### 10.2.3 Access control

PLL status and configuration can be accessed via registers

# LEON3FT Microcontroller

## 10.3 Registers

Table 66. PLL control and status registers

APB address offset	Register
0x8010D000	PLL Power Down configuration
0x8010D004	Reserved
0x8010D008	Select SpaceWire clock source and divisor
0x8010D00C	Select 1553B clock source and divisor
0x8010D010	Select FPGA Scrubber clock divisor
0x8010D014	Reserved
0x8010D018	Test clock enable
0x8010D070	PLL Interrupt status
0x8010D074	PLL Interrupt register
0x8010D078	PLL Interrupt mask
0x8010D07C	PLL Interrupt level
0x8010D080	PLL status register 0
0x8010D0E0	Configuration register
0x8010D0F0	Check Bits for registers
0x8010D0F4	Check Bits for registers
0x8010D0F8	Check Bits for registers
0x8010D0FC	Check Bits for registers
0x8010B000	Select system clock source
0x8010B004	Enable system clock error detector
0x8010D070	System Clock Select Interrupt status
0x8010D074	System Clock Select Interrupt register
0x8010D078	System Clock Select Interrupt mask
0x8010D07C	System Clock Select Interrupt level
0x8010B0E0	Configuration register
0x8010B0F0	Check Bits for registers
0x8010B0F4	Check Bits for registers
0x8010B0F8	Check Bits for registers
0x8010B0FC	Check Bits for registers

Table 67. 0x8010D000 - CFG - PLL configuration registers

31		5	4	3	2	1	0
	RESERVED		AL	PD			CFG
	0x00000000		0	0*			0*
	r		rw	rw			rw

31: 4      Reserved

4          Enable PLL alarm - Enable bit to include PLL in alarm matrix

# LEON3FT Microcontroller

Table 67. 0x8010D000 - CFG - PLL configuration registers

- 3 PLL power down (PD) - If this bit is written to 1, the PLL is powerdown. The PLL should always be in power down mode when not used, i.e., when the PLL is bypassed.
  - \* This register can be changed after reset due to bootstrap pins
- 2: 0 PLL configuration (CFG) - Internal PLL multiplier depended upon the input frequency of the PLL
  - 000b - when input frequency 200 MHz (division by 2)
  - 001b - when input frequency 100 MHz (division by 4)
  - 010b - when input frequency 50 MHz (division by 8)
  - 011b - when input frequency 25 MHz (division by 16)
  - 100b - when input frequency 12.5MHz (division by 32)
  - 101b - when input frequency 20 MHz (division by 20)
  - 110b - when input frequency 10 MHz (division by 40)
  - 111b - when input frequency 5 MHz (division by 80)
  - \* This register can be changed after reset due to bootstrap pins

Table 68. 0x8010D008 - SPWREF - Select reference for SpaceWire clock

31	24 23	16 15	10 9 8 7	0
RESERVED	DUTY	RESERVED	R	DIV
0x0	0x0	0x0	0x0	0
r	rw	r	rw	rw

- 31: 24 Reserved
- 23: 16 DUTY cycle for generated clock frequency - The duty cycle bitfield specifies how many of the total clock cycles specified in the DIV bitfield the generated clock shall be high. IF this register is set to 0x0 the duty cycle will be set to clock cycles defined in DIV and the clock period to 2xDIV.
- 15: 10 Reserved



# LEON3FT Microcontroller

Table 68. 0x8010D008 - SPWREF - Select reference for SpaceWire clock

- 9: 8 Reserved
- 7: 0 SpaceWire Reference Clock Divisor (DIV) - Set the divisor for input reference clock. Zero (default) bypass the divisor.

When bitfield DUTY period is set to 0x0 or 0x1. The input clock frequency will be divided by 2xDIV clock cycles with the duty cycle set to 50%. Valid configurations when DUTY period is set to 0 or 1:

- 0x00 - Bypass i.e. input frequency is divided by 1
- 0x02 - Divide input frequency by 4
- 0x04 - Divide input frequency by 8
- 0x06 - Divide input frequency by 12
- 0x08 - Divide input frequency by 16
- 0x0A - Divide input frequency by 20
- 0x0C - Divide input frequency by 24
- 0x0E - Divide input frequency by 28
- 0x10 - Divide input frequency by 32
- 0x14 - Divide input frequency by 40
- 0x16 - Divide input frequency by 44
- 0x18 - Divide input frequency by 48
- 0x1A - Divide input frequency by 52
- 0x1C - Divide input frequency by 56
- 0x1E - Divide input frequency by 60

All other combinations is not valid.

When bitfield DUTY period is equal or greater then 0x2. The DIV bitfield will divide the input frequency by DIV clock cycles and with the duty cycle defined in the DUTY bitfield.

- 0x04 - Divide input frequency by 4
- 0x06 - Divide input frequency by 6
- 0x08 - Divide input frequency by 8
- 0x0A - Divide input frequency by 10
- 0x0C - Divide input frequency by 12
- 0x0E - Divide input frequency by 14
- 0x10 - Divide input frequency by 16
- 0x14 - Divide input frequency by 20
- 0x16 - Divide input frequency by 22
- 0x18 - Divide input frequency by 24
- 0x1A - Divide input frequency by 26
- 0x1C - Divide input frequency by 28
- 0x1E - Divide input frequency by 30

All other combinations is not valid

Table 69. 0x8010D00C - MILREF - Select reference for 1553B clock

31	24 23	16 15	10 9 8 7	0
RESERVED	DUTY	RESERVED	SEL	DIV
0x0	0x0	0x0	0	0
r	rw	r	rw	rw

- 31: 24 Reserved
- 23: 16 DUTY cycle for generated clock frequency - The duty cycle bitfield specifies how many of the total clock cycles specified in the DIV bitfield the generated clock shall be high. IF this register is set to 0x0 the duty cycle will be set to clock cycles defined in DIV and the clock period to 2xDIV.
- 15: 10 Reserved

# LEON3FT Microcontroller

Table 69. 0x8010D00C - MILREF - Select reference for 1553B clock

- 9: 8 1553B Reference Clock (SEL) - Select 1553B reference clock and source
- 0x0 - Clock source from external signal SYS\_CLK
  - 0x1 - External 1553B clock pin selected by the IO mux
  - 0x2 - Clock source from external signal SPW\_CLK
  - 0x3 - Clock generated from PLL
- External or active 1553B clock is selected via IO mux configuration
- 7: 0 1553B reference Clock Divisor (DIV) - Set the divisor for input reference clock. Zero (default) bypass the divisor.
- When bitfield DUTY period is set to 0x0. The input clock frequency will be divided by 2xDIV clock cycles with the duty cycle set to 50%
- When bitfield DUTY period is larger then 0x1. The DIV bifield will divide the input frequency by DIV clock cycles and with the duty cycle defined in the DUTY bitfield

Table 70. 0x8010D010 - SCLKREF - Select reference for FPGA Scrubber clock

31	24 23	16 15	10 9 8 7	0
RESERVED	DUTY	RESERVED	R	DIV
0x0	0x0	0x0	0x0	0
r	rw	r	rw	rw

- 31: 24 Reserved
- 23: 16 DUTY cycle for generated clock frequency - The duty cycle bitfield specifies how many of the total clock cycles specified in the DIV bitfield the generated clock shall be high. IF this register is set to 0x0 the duty cycle will be set to clock cycles defined in DIV and the clock period to 2xDIV.
- 15: 10 Reserved

# LEON3FT Microcontroller

Table 70. 0x8010D010 - SCLKREF - Select reference for FPGA Scrubber clock

- 9: 8 RESERVED
- 7: 0 FPGA Scrubber Reference Clock Divisor (DIV) - Set the divisor for input reference clock. Zero (default) bypass the divisor.

When bitfield DUTY period is set to 0x0 or 0x1. The input clock frequency will be divided by 2xDIV clock cycles with the duty cycle set to 50%. Valid configurations when DUTY period is set to 0 or 1:

- 0x00 - Bypass i.e. input frequency is divided by 1
- 0x02 - Divide input frequency by 4
- 0x04 - Divide input frequency by 8
- 0x06 - Divide input frequency by 12
- 0x08 - Divide input frequency by 16
- 0x0A - Divide input frequency by 20
- 0x0C - Divide input frequency by 24
- 0x0E - Divide input frequency by 28
- 0x10 - Divide input frequency by 32
- 0x14 - Divide input frequency by 40
- 0x16 - Divide input frequency by 44
- 0x18 - Divide input frequency by 48
- 0x1A - Divide input frequency by 52
- 0x1C - Divide input frequency by 56
- 0x1E - Divide input frequency by 60

All other combinations is not valid.

When bitfield DUTY period is equal or greater then 0x2. The DIV bitfield will divide the input frequency by DIV clock cycles and with the duty cycle defined in the DUTY bitfield.

- 0x04 - Divide input frequency by 4
- 0x06 - Divide input frequency by 6
- 0x08 - Divide input frequency by 8
- 0x0A - Divide input frequency by 10
- 0x0C - Divide input frequency by 12
- 0x0E - Divide input frequency by 14
- 0x10 - Divide input frequency by 16
- 0x14 - Divide input frequency by 20
- 0x16 - Divide input frequency by 22
- 0x18 - Divide input frequency by 24
- 0x1A - Divide input frequency by 26
- 0x1C - Divide input frequency by 28
- 0x1E - Divide input frequency by 30

All other combinations is not valid

Table 71. 0x8010D018 - TCTRL - Test Clock Enable

31	6	5	4	3	2	1	0
	PL	FS	MC	SP	SC	EN	
0x0	0	0	0	0	0	0	
r	rw	rw	rw	rw	rw	rw	

- 31: 6 Reserved
- 5 PL - Enable of PLL LOCK - when enabled the internal PLL lock signal is available on GPIO 19
- 4 FS - Enable of FPGA Scrubber clock - when enabled the internal FPGA Scrubber clock is available on GPIO 20
- 3 MC- Enable of MIL-1553 clock - when enabled the internal MIL-1553 clock is available on GPIO 21
- 2 SP- Enable of SpaceWire clock- when enabled the internal SpaceWire clock is available on GPIO 22
- 1 SC - Enable of System clock - when enabled the internal system clock is available on GPIO 23
- 0 EN- Enable of output test clocks and PLL lock signal

# LEON3FT Microcontroller

Table 72. 0x8010D070 - STS - PLL interrupt status register

31		4	3	2	1	0
	RESERVED	BP	SC	XO	CL	
	0x00000000	-	-	-	-	
	r	r	r	r	r	

- 31: 4 Reserved
- 3 Bit parity check error (BP) - Configuration bit error detection
- 2 System Clock Error (SC) - System Clock Error detection
- 1 XO Connection (XO) - XO no crystal detection
- 0 PLL clock lock (CL) - Shows the current value of the PLL lock output.

Table 73. 0x8010D074 - IRQ - PLL interrupt register

31		4	3	2	1	0
	RESERVED	BP	SC	XO	CL	
	0x00000000	-	-	-	-	
	r	wc	wc	wc	wc	

- 31: 4 Reserved
- 3 Bit parity check error (BP) - Configuration bit error detection
- 2 System Clock Error (SC) - System Clock Error detection
- 1 XO Connection (XO) - XO no crystal detection
- 0 PLL clock lock (CL) - Shows the current value of the PLL lock output.

Table 74. 0x8010D078 - MASK - PLL mask register

31		4	3	2	1	0
	RESERVED	BP	SC	XO	CL	
	0x00000000	0	0	0	0	
	r	rw	rw	rw	rw	

- 31: 4 Reserved
- 3 Bit parity check error (BP) - Configuration bit error detection
- 2 System Clock Error (SC) - System Clock Error detection
- 1 XO Connection (XO) - XO no crystal detection
- 0 PLL clock lock (CL) - Shows the current value of the PLL lock output.

Table 75. 0x8010D07C - LVL - PLL interrupt level register

31		4	3	2	1	0
	RESERVED	BP	SC	XO	CL	
	0x00000000	0	0	0	0	
	r	rw	rw	rw	rw	

- 31: 4 Reserved
- 3 Bit parity check error (BP) - Configuration bit error detection
- 2 System Clock Error (SC) - System Clock Error detection

# LEON3FT Microcontroller

Table 75. 0x8010D07C - LVL - PLL interrupt level register

- 1 XO Connection (XO) - XO no crystal detection
- 0 PLL clock lock (CL) - Shows the current value of the PLL lock output.

Table 76. 0x8010D080 - PLLSTS - PLL status register

31	RESERVED	3	2	1	0
	0x00000000		XP	XO	CL
	r			-	-
				r	r

- 31: 2 Reserved
- 2 XO Power Down Status (XP) - XO power down status
- 1 XO Connection (XO) - XO no crystal detection
- 0 PLL clock lock (CL) - Shows the current value of the PLL lock output.

Table 77. 0x8010B000 - SYSEL - System clock source configuration register

31	RESERVED	3	2	0
	0x0			SEL
	r			rw

- 31: 3 Reserved
- 2: 0 Select system input clock source
  - 0x0 - System clock from external SYS\_CLK clock
  - 
  - 0x6 - System clock from external SYS\_CLK clock
  - 0x7 - System clock from internal SPW\_CLK clock

Table 78. 0x8010B004 - DETEN - System clock error detector enable register

31	RESERVED	3	2	0
	0x0			EN
	r			rw

- 31: 3 Reserved
- 2: 0 Enable clock error detector
  - 0x0 - Disable detector
  - 0x1 - Enable detector
  - 
  - 0x7 - Enable detector

# LEON3FT Microcontroller

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## 11 Voltage and Current References

### 11.1 Overview

The internal voltage and current reference block provides accurate reference voltage and currents in the system.

### 11.2 Operation

#### 11.2.1 System overview

The internal voltage and current references consist of a bandgap reference providing a high-impedance unbuffered voltage of nominal 1V and a bias block generating accurate bias currents. The bias block includes a temperature sensor compatible with the ADC IP to enable digital temperature read out.

#### 11.2.2 Detailed description

The reference blocks, internal voltage reference and current reference generator, are supplied by `VDDA_REF` and `VSSA_REF`. It is essential that there is good PCB decoupling on this supply, especially at high frequencies, since the on-chip disturbance suppression commonly is poor at high frequencies, which would result in high-frequency disturbance transferred directly onto the references used by analog blocks such as ADC and DACs.

Another decoupling capacitor, which is the most critical (sensitive) one for the whole Microcontroller, is on the internal voltage reference output pin, `VREF`. This decoupling capacitance should be 4.7nF located very close to the `VREF` pin, and grounded (very close) to the `VSSA_REF` pin. There should be no other components on PCB connected to the `VREF` pin, and its PCB layout connection should not extend beyond the decoupling capacitor, to avoid disturbance on this pin. Preferably, a `VSSA_REF` local ground plane and guard ring around this pin should be implemented in the PCB layout.

The reference buffer providing `VREFBUF` is a buffer amplifier with gain 1.9 of `VREF`. The maximum load current on `VREFBUF`, with full voltage performance maintained, is 20mA. It can be used, for example, to perform accurate bridge measurements with the ADC, such as thermistor measurements, or wherever a reference voltage (referred to `VSSA_REF`) is needed in application circuits on PCB. It is, however, critical that no fast current load steps are present on the `VREFBUF` output, since that can cause erroneous voltage transients.

The reference resistor, `RREF`, sets all the reference currents for internal bias currents and the fullscale current for the four DACs. Therefore, it is critical that `RREF` always is within 4.9-5.3 kohm over worst-case conditions. The DAC fullscale current is proportional to the current through `RREF`, where 5.11 kohm gives a nominal fullscale current of 4.0mA.

For further details refer section 57.10.

# LEON3FT Microcontroller

## 12 ADC, Pre-Amplifier and Analog MUX

### 12.1 Overview

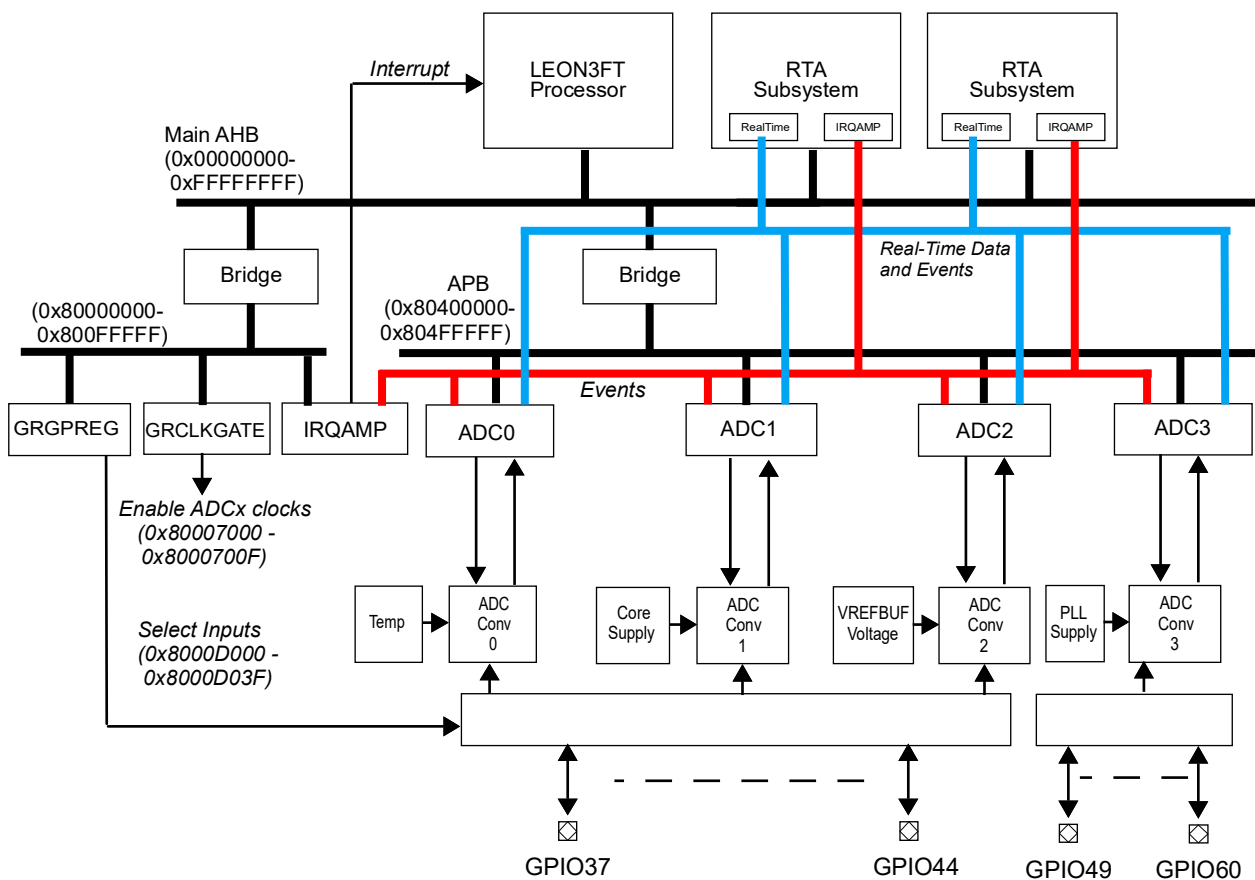
The GR716 has 4 separate sets of Analog-to-Digital Converters (11-14 bit ADCs), pre-amplifiers, input multiplexers and control units. Each integrated analog multiplexer (MUX) supports connection to 1 internal channel and 8 external GPIO pins. GPIO 37-44 are the 8 external MUX pins for ADC0, ADC1 and ADC2, i.e., the same 8 GPIO pins are internally connected to all three ADC MUXs in parallel. GPIO 51-58 are the 8 external MUX pins for ADC3. Each ADC converts an analog single-ended or differential input signal to an 11 to 14 bit digital output, in ADC conversion mode 0 to 3, respectively. See section 57.8 for electrical specifications of ADC mode 0 to 3, and section 2.3.5 for ADC connection diagrams.

The ADC control and status registers are accessible via digital ADC control units directly from RTA and LEON3 processor. These units support a number of features including synchronization to ADC-start trigger, autonomous sequences and level detections, to off-load the processors. The ADC control units are located on APB bus in the address range from 0x80400000 to 0x80403FFF.

Figure 19 shows an overview of the ADC converters and the ADC control unit connections. The figure shows memory locations and functions used for ADC configuration and control. Each control unit has access to its input MUX and external input pins, amplifier and ADC, and has a unique AMBA address described in chapter 2.10. All control units have identical configuration and status registers. These registers are described in section 12.3.

ADC status signals can be accessed instantaneously by the RTA on the *Real-time Data and Event* bus shown in figure 19.

Figure 19. GR716 ADC bus and pin connections



# LEON3FT Microcontroller

The primary clock gating unit **GRCLKGATE** described in chapter 27 is used to enable/disable individual ADC converters and ADC control units. The unit **GRCLKGATE** can also be used to perform reset of individual ADC control units. Software must enable clock and release reset described in chapter 27 before ADC configuration and sampling can start.

External IO selection per ADC input pin is made in the system IO configuration register (**GRG-PREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

The system can be configured to protect and restrict access to individual ADC units in the **MEM-PROT** unit. See chapter 47 for more information.

## 12.2 Operation

### 12.2.1 System overview

Each ADC operates individually per conversion, in conversion mode 0, 1, 2 or 3, and measures any one analog input MUX channel, where mode 0 provides 11bit/500kSps and mode 3 provides 14bit/80kSps, and mode 1 to 3 provide SET detection status flag. One MUX channel at a time is measured in single-ended mode, i.e., one analog input pin is measured relative ground, or measured in differential-input mode, i.e., two analog input pins are measured differentially. The fullscale range in single-ended mode is 0V to 2.5V, and in differential mode it is -2.0V to 2.0V. See section 2.3.5 for connection diagrams of ADC, MUX and pre-amplifier, and see section 57.8 for ADC mode 0 to 3 and further electrical specifications.

Each ADC MUX has 8 analog inputs, which are connected to 8 GPIO pins. Each of ADC0-2 has its 8 MUX inputs connected to GPIO 37-44, i.e., these three ADCs are connected to the same 8 GPIO pins. And each ADC can measure any of these 8 GPIO pins independently at any time. The ADC3 MUX is connected to GPIO 51-58. Additionally, each ADC MUX has one more analog input, internally connected to one internal analog source. For ADC0, ADC1 and ADC2, these sources are the internal temperature sensor, the core supply voltage, and the VREFBUF output voltage, respectively. For ADC3, it is the PLL supply voltage. All GPIO pins to the analog MUX can be disconnected, which is an easy way to ensure that a certain ADC input is not disturbed by another ADC input, i.e., another ADC MUX that switches to a certain GPIO should not be allowed to disturb an on-going measurement (during track time). The ADC can also be powered down by using the control unit to save power consumption.

Between the ADC and the MUX there is a fully differential pre-amplifier which has three programmable gain settings (x1, x2, x4), and is to be used with the differential ADC mode. The amplifier can be bypassed using the control unit, and be powered down independently of the ADC.

ADC0, ADC1 and ADC2 are supplied by  $V_{DDA\_ADC}$  and  $V_{SSA\_ADC}$ , and ADC3 is supplied by  $V_{DD\_IO}$  and GND. When an ADC is to be used, its supply needs to be well decoupled at high frequencies (>1MHz) to not degrade ADC performance. Regarding grounding,  $V_{SSA\_ADC}$  must be locally connected to same PCB ground as  $V_{SSA\_REF}$ , to guarantee ADC full functionality and performance.

### 12.2.2 Detailed description

The on-chip ADC, pre-amplifier and input analog MUX have a digital control and status interface accessible via registers on the APB bus. This digital control unit supports CPU off-loading, autonomous sequence measurements, level detection and other features. The digital interface also supports sampling modes to suppress noise and to increase the resolution and ENOB further than the raw data from ADC mode 0 to 3. Improvement of resolution and ENOB is supported by oversampling and higher gain settings in the pre-amplifier in case of weak signal power from the analog source. In order to make oversampling effective, the input signal needs to be an AC signal, or DC signal with dithering, i.e., added random noise of more than one LSB magnitude. AC signal is defined such that consecutive samples have independent quantization error, which commonly is fulfilled for signals that change at least an order of magnitude more than one LSB between consecutive samples.



# LEON3FT Microcontroller

The digital control logic supports the following **Sampling modes and configurations**:

- The input can either be sampled **directly or synchronized to a trigger** source using Sequence synchronization mode. A conversion is starting first after the ADC conversion start field is set via a register access.
- **Oversampling and shift** to extend the number of effective bits. The number of samples to be accumulated and divided is controlled via registers. The number of samples to be accumulated can be configured in the range of 1 to **65526 (65535 TBD)**. The accumulated data could be 20 bits large and includes overflow detection. Division is supported by shift in the range of 0 to 31 steps and includes rounding. For each additional bit resolution, the signal must be oversampled by a factor of four.
- **Sequence sampling** for autonomous collection of more than one data. The digital ADC logic interface supports configuration of up to 4 independent A/D conversions, with independent conversion setups and output buffers, called events and controlled by separate independent register fields. The sequence sampler can be combined with the oversampler and shift. For example 4 events could be captured, each with 32 accumulated samples that are shifted 5 times to generate an average of the 32 samples. There is also a **Continuous sampling mode** that will continuously capture data until canceled by the user. Continuous mode is supported in both Sequence synchronization mode and direct sampling, as well as any number of events.

**Triggers** are used for starting a conversion in Sequence synchronization mode. When a trigger event occur, the channel value will be recorded and stored in the status register. Trigger sources includes GPIOs, timer units and PWM ticks. The trigger type is configurable to edge (rising, falling or both) or level (high or low). Triggers can be used for multiple events and in continuous sampling mode. There is a Trigger synchronization feature that can be used to synchronize the ADC clock to the trigger source. This is useful to get a known time relative to the trigger when data is captured.

The ADC clock is internally generated within the control unit block from the system clock frequency using a scaler. The **Track time** is programmable in steps of ADC clock cycles allowing it to be optimized for different inputs and analog signal sources. For details on available Track time and Conversion time in the different ADC modes, see section 57.8.

**Interrupt generation** for autonomously **Level detection** of internal and external voltage levels can be enabled. The digital ADC will generate an interrupt to the processor if the interrupts are enabled and the measured voltage level is above or below configured thresholds. The level detection needs to be enabled in order to generate an interrupt. For autonomous level detection the control unit should be configured in Continuous mode. Other supported interrupt includes End of conversion and End of sequence. End of conversion interrupt is generated for each completed event (all accumulated samples in one event captured), End of sequence interrupt is generated when the last event is captured. These two interrupts can be configured to be auto-cleared. All interrupts can be masked.

There are several ways to **Stop** an ongoing conversion or sequence. If in Sequence continuous mode, the mode needs to be disabled. This will complete the ongoing event prior to stop conversion. If manually clear the Conversion start signal, the ongoing event will be completed prior to activity is stopped. There is also a Stop signal that immediately will cancel ongoing activity going back to an idle state. Turning of the ADC bias will cancel all ongoing activities and set the control unit in an idle state.

For **low noise measurements** of external sources and DMA transfers to **off-load the processor**, interrupts need to be setup and used by the system. To perform a low noise measurement on an ADC channel, most of the internal clock network needs to be disabled and the IOs next to the ADC input pins need to be silent. The system software needs to program the ADC to trigger and sample an input using an external or internal trigger while system is in sleep mode. The same trigger or timer can be used to wake the processor if needed. DMA transfers can be triggered by the interrupt generated by the ADC interface. Simple or multiple transfers of ADC samples to internal or external RAM can be setup and made by the DMA controller in the LEON3FT microcontroller.

# LEON3FT Microcontroller

## 12.2.3 Increasing the resolution of an ADC measurement

Applications measuring a large dynamic range, yet require fine resolution to measure small changes in a parameter. Via oversampling and averaging, the resolution could be improved an order of magnitude from the internal ADC.

To increase the effective number of bits (ENOB) by 1, the signal must be oversampled by a factor of four. E.g., to support an ADC resolution improvement of 3 bits, the ADC controller needs to be configured to oversample the signal by 64. For example, using ADC mode 0 (11bit) to output a temperature value once every second (1Hz), and increasing the resolution to 14bit, we calculate the oversampling frequency as follows:  $\text{Sample Frequency} = 4^{(14-11)} \times 1\text{Hz} = 64\text{Hz}$ .

Thus, if we sample the temperature sensor at 64Hz, we will collect enough samples within the required sampling period to average them and now have a result with 14bit effective resolution. Once this result has been calculated, it is stored in the status register of the ADC, and the procedure begins again with collection of data for the next temperature result.

To further enhance the ENOB the system can make use of the pre-amplifier and/or use dithering, i.e., random noise can be introduced to the external signal.

## 12.2.4 Chip low-noise condition during ADC sampling and conversion

The LEON3FT microcontroller supports ADC operation in low-noise microcontroller mode, i.e., the LEON3FT microcontroller can disable the LEON3FT processor and peripherals not needed by the system, to minimize ADC measurement noise introduced internally by the LEON3FT microcontroller itself.

To be able to operate or be able to sample and wake-up the application shall:

- Set the PSR.PIL register low enough for processor to wake-up from expected interrupt
- Keep clocks enabled for peripherals generating the expected interrupt

Failure to keep expected interrupt source enabled will most likely result in the watch-dog wake-up the processor.

For low noise sampling the user application shall:

- Enable ADC clock for channel to use
- Disable all other interfaces or peripherals not needed in the clock gating unit
- Enable interrupt generation in ADC or if the DMA is used the DMA controller can be set to generate the interrupt to wake-up the processor
- Start sampling and set the LEON3FT microcontroller in power down mode. See 17.1.6

## 12.2.5 Real-time data and event bus

Data sampled and stored in the ADC Sequence status register 0, 1, 2 and 3 can be accessed instantaneously on the *Real-time Data and Event bus*. Data can be sampled from same or different external source. An event is generated on the *real-time bus* to announce that the current sampled value has changed.

## 12.2.6 Continuous sampling and trigger based sampling in real-time systems

In application or scenarios, where the order of events can be predicted, that requires fast continuous sampling of one upto four external sources must use triggers to sample and store data. The ADC controller use triggers to automatically sample and switch between analog sources.

To minimize the effect of switching between analog sources, the ADC controller can reconfigure the analog switch and start tracking of the next source when the current source has been sampled and A/D converted. It does not need to wait till the trigger occurs for the next measurement. In this scenario the A/D conversion will start immediately at the next event since it is assumed that the effects of analog

switching and track settling are taken care of by the time between the two consecutive events. A prerequisite for fast continuous sampling of one upto four external sources is that the analog sources expected to be sampled are programmed in the correct order in the Sequence Sampling configuration register (ACS). An event can never trigger an event earlier than the number of ADC lock cycles specified in the track-time register (ASYNC.TT). For each completed event data is stored in the ADC status register (ASTS.AD). Data is also stored into one of the ASQ registers simultaneously. The events configuration (ASAMPC.AE) sets how many registers to be used, starting with ASQ0 and increasing for each completed event. If continuous mode is used (ASEQC.SC = 1) and the last event have been saved, the sequence will be repeated with next data saved in ASQ0 again.

In applications or scenarios where the order of events cannot be predicted, the track time specified in the register ASYNC.TT must be large enough to minimize the effects of switching between analog sources. In out-of-order scenario (ASEQC.SO = 1) samples will be stored in associated ASQ register i.e. an event on selected ASYNCM.SYNC0 will store sample in ASQ0 and event on selected ASYNCM.SYNC1 will store sample in ASQ1 etc.

### 12.2.7 ADC Track-time configuration

The internal sample and hold (S/H) circuit in the ADC has two different states: track state and hold state. In track state, the internal S/H capacitor is connected to the analog signal source to be measured. When the internal pre-amplifier is used, see figure 10, the S/H capacitor is connected to the pre-amplifier output, which is applicable only in ADC differential input mode. When the internal pre-amplifier is by-passed, the S/H capacitor is connected directly to the GPIO pin(s). By-pass mode can be used either in single-ended or differential input mode. In differential mode, the S/H circuit consists of two independent S/H capacitors to ADC ground.

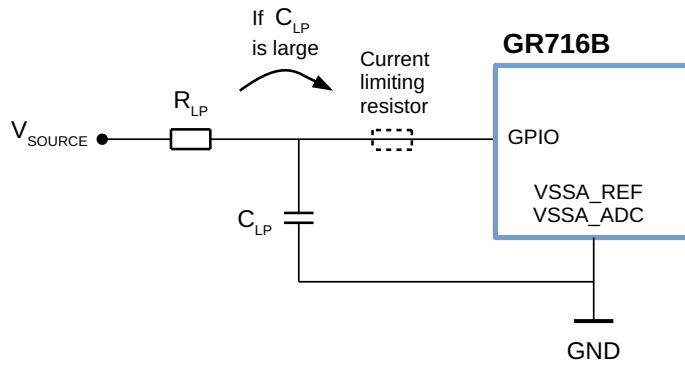
The end time point of track state, when going into hold state, is when the analog voltage in the S/H capacitor goes from following the input source to becoming frozen. Therefore, this is the time point to be regarded the sample time point of the analog input signal. It is critical that the analog signal source gets enough time, with the S/H circuit in track state, for the S/H capacitor voltage to settle accurately before the track time ends. This settling should go on at least until the residual settling voltage error is 1 LSB or smaller. Here, 1 LSB refers to the ADC resolution for the A/D conversion mode 0 to 3 to be executed.

The track time is individually selectable per A/D conversion, separately from selection of mode 0 to 3. See table 79 for minimum required track settling time in ADC by-pass mode, for different hardware designs on PCB, and table 80 for internal channels. In section 57.8, maximum track time and ADC electrical specifications are presented for mode 0 to 3, where it can be seen that the S/H capacitance is roughly 25pF.

$R_{LP}$  and  $C_{LP}$  in table 79 form a low-pass filter, see figure 19, where  $C_{LP}$  should be placed close to the GPIO pin. When  $C_{LP}$  is inserted differentially, between two differential GPIO pins, the capacitance value in table 79 together with half the  $R_{LP}$  value inserted in each differential line will give equivalent filtering.

# LEON3FT Microcontroller

Figure 20. Low-pass RC filter on ADC GPIO input pin



The minimum track time, which always must be fulfilled, is 0.6 $\mu$ s for mode 0 and 0.8 $\mu$ s for mode 1 to 3, or up to 1.0 $\mu$ s to fully benefit from mode 2 and 3 ADC resolution. When the pre-amplifier is used, it is always enough to use these minimum track times. However, note that the pre-amplifier input ( $R_{IN,diff} = 80/50/30\text{ k}\Omega_{typ}$ , for gain x1/x2/x4) is only connected to the two selected GPIO pins *during* track time. This can cause need of a re-settling time on the GPIO pins, depending on the PCB signal source, which also may need to be taken into account in selection of the track time.

Table 79. Track settling time ( $t_{track}$ ) that gives 1 LSB accuracy for ADC by-pass mode, including  $C_{LP}$  tolerance of  $\pm 20\%$  and maximum internal S/H capacitance. No controlled precharge of the S/H capacitor is assumed (see section 12.2.8). For specification of mode 0 to 3, see section 57.8.

$C_{LP}$ [pF <sub>nom</sub> ]	$R_{LP}$ [ $\Omega_{max}$ ]	$t_{track}$ [ $\mu$ s <sub>min</sub> ]		Comment
		Mode 0	Mode 1 - 3	
0	600	0.6	0.8	PCB source is continuously on, or turns on fast ( $\ll t_{track}$ ) at track start. PCB parasitics of upto 25pF taken into account.
0	1000	0.8	1.0	
0	10000	6	8	
33	500	0.6	0.8	
33	1000	0.9	1.2	
33	10000	7	9	

# LEON3FT Microcontroller

**Table 79.** Track settling time ( $t_{\text{track}}$ ) that gives 1 LSB accuracy for ADC by-pass mode, including  $C_{\text{LP}}$  tolerance of  $\pm 20\%$  and maximum internal S/H capacitance. No controlled precharge of the S/H capacitor is assumed (see section 12.2.8). For specification of mode 0 to 3, see section 57.8.

$C_{\text{LP}}$ [pF <sub>nom</sub> ]	$R_{\text{LP}}$ [ $\Omega_{\text{max}}$ ]	$t_{\text{track}}$ [ $\mu\text{s}_{\text{min}}$ ]		Comment
		Mode 0	Mode 1 - 3	
100	400	0.6	0.8	PCB source is continuously on, and capacitively disturbed by track turn on. PCB parasitics of upto 25pF taken into account.
100	1000	1.2	1.6	
100	10000	11	15	
330	200	0.6	0.8	
330	400	1.1	1.5	
330	1000	2.5	3.5	
330	10000	25	35	
1000	80	0.6	0.8	
1000	400	2.3	3.4	
1000	1000	6	9	
1000	10000	60	90	
100 nF <sub>nom</sub>	600 <sup>1)</sup>	0.6	--- <sup>2)</sup>	
1 $\mu\text{F}_{\text{nom}}$	600 <sup>1)</sup>	0.6	0.8	

Note 1: This is a protection resistor (min 330 $\Omega$ ) against transient overcurrent (max 10mA) out of  $C_{\text{LP}}$  going into GPIO pin during power down, applicable for large  $C_{\text{LP}}$  ( $> \sim 10\text{nF}$ ). It is inserted in-between  $C_{\text{LP}}$  and GPIO pin, see figure 19 where  $R_{\text{LP}}$  is moved, and both are placed as close to GPIO pin as possible. Note that on these two table rows,  $R_{\text{LP}}$  does not form any low-pass filter with  $C_{\text{LP}}$ , since  $R_{\text{LP}}$  is moved to the other side of  $C_{\text{LP}}$ . Any desired low-pass characteristics needs to be designed by  $C_{\text{LP}}$  together with the signal source impedance, which often comes naturally for common source impedances together with these large values of  $C_{\text{LP}}$ .

Note 2: Charge ejection in ADC by-pass mode causes more than 1 LSB voltage change in 100nF capacitance for ADC mode 1 to 3, and it takes very long time to re-settle the voltage in this large capacitance. Therefore, the order of 100nF is very unfavorable for these three ADC modes. Instead, at least 1 $\mu\text{F}$  should be used here which gives less than 1 LSB change caused by track turn on in by-pass mode.

**Table 80.** Track settling time ( $t_{\text{track}}$ ) for measurement of internal ADC channels, only available in by-pass differential mode. No controlled precharge of the internal S/H capacitors is assumed. For specification of mode 0 to 3, see section 57.8.

ADC#	Internal MUX channel	$t_{\text{track}}$ [ $\mu\text{s}_{\text{min}}$ ]	
		Mode 0	Mode 1 - 3
ADC0	Temperature sensor (ch. 14)	6	8
ADC1	$V_{\text{DD\_CORE}}$ supply (gain 0.6)	0.8	1.0
ADC2	$V_{\text{REFBUF}}$ output (gain 1.0)	0.8	1.0
ADC3	$V_{\text{DDA\_PLL}}$ supply (gain 0.6)	0.8	1.0

### 12.2.8 Precharge of S/H capacitor for control of GPIO disturbance transients

The main usage of S/H capacitor precharge is before an upcoming ADC measurement in by-pass mode. The reason is that transient disturbance on GPIO pin can occur when doing ADC by-pass measurements. It occurs when the S/H capacitor connects to the GPIO pin, at the track start time point. A purpose of precharge can be to control the sign of this GPIO pin transient, when ACOMP has a known trig level configured on the same GPIO pin, to ensure that no false ACOMP trigs occur. Another purpose of precharge can be to start the upcoming ADC track settling on a well controlled voltage in the S/H capacitor(s), possibly even known to be close to the final track-settling voltage, to minimize the required track time in the upcoming ADC measurement.

During ADC idle state, the internal S/H capacitor(s) can be configured to be discharged to ground potential or precharged to some deterministic potential. The discharge/precharge is an RC time-constant settling ( $\tau$  with exponential settling) that depends on the internal S/H capacitance and DC source resistance. The time needed for such settling depends on how accurately it needs to settle. For example  $4\tau$ , giving about 2% rest voltage, would mean a settling time of maximum  $4 \cdot 50\text{ns} = 200\text{ns}$ , based on “Internal ground” in table 81. All available signal sources for S/H capacitor precharge are presented in this table.

Precharge is always done differentially, i.e., on both ADC S/H capacitors, when an internal ADC channel is used. When precharge is done from GPIO pin(s), see last row in table 81, either single-ended or differential precharge can be selected.

# LEON3FT Microcontroller

Alternatively, the S/H capacitor can be disconnected/floating in ADC idle state, see first row in table 81. Then, the latest sampled voltage will be kept until internal leakage causes arbitrary drifts, which can be in the order of 10mV/ms at high temperature.

Table 81. Time constant ( $\tau$ ) and final settling voltage for S/H capacitor precharge in ADC idle state. When running consecutive A/D conversions, the ADC controller inserts 1 (TBC)  $f_{\text{adc,clk}}$  cycle in-between two consecutive conversions.

ADC#	Typ $\tau$ [ns]	Max $\tau$ [ns]	Settling [V]	Analog MUX channel	ADC Configuration
ADC0-3	---	---	---	Disconnected/floating S/H capacitor(s)	ADC0: TBD ADC1: TBD ADC2: TBD ADC3: TBD
ADC0-3	25	50	0	Internal ground	ADC0: TBD ADC1: TBD ADC2: TBD ADC3: TBD
ADC0	300	800	Pos: 0.9 - 1.7 Neg: 1.0	The internal ADC channel. Voltage depends on Temp Sensor.	Non-inverted: TBD <sup>1)</sup> Inverted: TBD <sup>1)</sup>
ADC1	50	100	Pos: 1.2 - 1.6 Neg: 0.3 - 0.4	The internal ADC channel. Voltage depends on $V_{\text{DD\_CORE}}$ .	Non-inverted: TBD <sup>1)</sup> Inverted: TBD <sup>1)</sup>
ADC2	50	100	Pos: 1.9 Neg: 0	The internal ADC channel. Voltage is $V_{\text{REFBUF}}$ .	Non-inverted: TBD <sup>1)</sup> Inverted: TBD <sup>1)</sup>
ADC3	50	100	Pos: 1.36 - 1.60 Neg: 0.34 - 0.40	The internal ADC channel. Voltage depends on $V_{\text{DDA\_PLL}}$ .	Non-inverted: TBD <sup>1)</sup> Inverted: TBD <sup>1)</sup>
ADC0-3	25	50	$V_{\text{GPIO}}$	External GPIO pin driven by <b>0<math>\Omega</math></b>	See table TBD (or extend this table with all GPIOs)
	50	100		External GPIO pin driven by <b>1k<math>\Omega</math></b>	

Note 1: In 'Non-inverted' configuration, the positive ADC S/H capacitor is precharged by the 'Pos:' voltage, and the negative capacitor is precharged by the 'Neg:' voltage. In 'Inverted' configuration, the precharge is vice versa. Note that any upcoming *single-ended* ADC measurement will connect the *positive* ADC S/H capacitor to GPIO pin during track time (and negative capacitor internally grounded), so 'Non-inverted' is used for 'Pos:' precharge and 'Inverted' for 'Neg:' precharge.

For example, to settle the S/H capacitor voltage to  $<0.1\text{V}$  in ADC idle state, when starting from any voltage up to  $3.6\text{V}$ , will require discharge time up to  $3.6\tau$ . Using discharge by 'Internal ground' means that up to  $3.6 \cdot 50\text{ns} = 180\text{ns}$  is required. Precharge from external GPIO pin, driven by 0 ohm on PCB, gives the same required time, i.e., up to  $3.6 \cdot 50\text{ns} = 180\text{ns}$ . But here, it will ensure settling to the GPIO DC voltage level instead, with accuracy better than  $0.1\text{V}$ .

With S/H capacitor discharged to  $<0.1\text{V}$ , consequently, the next GPIO to be ADC by-pass measured cannot be transiently disturbed by the S/H capacitor to any higher voltage than  $0.1\text{V}$ . If this GPIO is driven by a PCB signal with range of  $0\text{V}$  to  $0.1\text{V}$ , e.g. a current-sense resistor in ground line, the GPIO will never go above  $0.1\text{V}$ , not even transiently. Thus, on the same GPIO pin, also an ACOMP trig level of, e.g.,  $125\text{mV}$  could be configured as an overcurrent limit protection. More generally, as long as the S/H capacitor precharge level is guaranteed to be lower than the maximum level of PCB normal signal range, an ACOMP trig level down to the normal-range maximum level can be configured on the same GPIO pin. Some tolerance and disturbance margin would still be recommended though, e.g., see the analog MUX switching transients below.

Note that with the S/H capacitor fully discharged to  $0\text{V}$  during ADC idle state, a GPIO transient could go all the way down to  $0\text{V}$  at the next ADC by-pass measurement, but it is strongly dependent on the signal source impedance on PCB how deep the transient will be. After the transient, the GPIO voltage

re-settles to the PCB source voltage level with a time constant that depends on the PCB source impedance. As usual, this re-settling needs to be completed accurately within the selected track time, as described earlier. Hence, keep in mind that the purpose of precharge is not to eliminate GPIO transients, caused by ADC S/H capacitor in by-pass measurements. The purpose is mainly to control the sign of the transient, e.g., to avoid false ACOMP trigs, and possibly other transient problems on PCB if this GPIO-pin net is used elsewhere on PCB. The purpose can also be to minimize the track time of an upcoming ADC by-pass measurement, in cases where the PCB signal has a narrow and well known normal-signal range.

In regard to ADC offset and linearity, in ADC by-pass mode that needs long track times, both offset and linearity can be unaffected even though the track settling is incomplete. Track time (and settling  $\tau$ ) must then be the same for all samples, and ADC idle-state precharge must be performed accurately to 0V (or another accurate DC level). Then, there will be only gain error (decreased gain) due to incomplete settling, since constant settling time gives constant relative settling residual in exponential settlings. If the idle-state precharge is not completed to 0V, but at least accurately to the same voltage level for all samples, it can be compensated by ADC offset calibration.

### 12.2.9 GPIO filter capacitor for ACOMP -- Against short MUX disturbance transients

Always when ACOMP is used, at the same time as *any* ADC measurement is executed on the same GPIO pin, false ACOMP switchings can occur. This is caused by analog switches in the internal ADC channel-selection MUX, which eject small amounts of charge back out on the GPIO pin. To guarantee that no such false ACOMP switchings occur, these charge transients need to be suppressed by a small low-pass filter capacitor to ground on PCB,  $C_{LP,ACOMP}$ , placed close to the GPIO pin.

Note that these switching transients are not related to the S/H capacitor(s), but they come from the internal ADC MUX connecting the GPIO pin to the ADC. They contain much lower charge levels than the S/H capacitor transients, and can therefore be filtered by relatively small capacitance values, see table 82 for recommended values.

Table 82. Required low-pass filter capacitor,  $C_{LP,ACOMP}$ , on GPIO pin for guaranteed maximum GPIO transient, caused by ADC MUX switchings. Capacitance tolerance of  $\pm 20\%$  taken into account for  $C_{LP,ACOMP}$ .

$C_{LP,ACOMP}$ [pF <sub>nom</sub> ]	Transient [mV <sub>peak,max</sub> ]
33	150
100	50
330	15
1000	5

Hence, when no false ACOMP switching is allowed, and the GPIO pin is driven by a series resistor on PCB such as a current-limiting resistor of  $330\Omega_{\min}$  or the 100nF/1uF case in table 79, then  $C_{LP,ACOMP}$  according to table 82 always is required. And consequently, when adding such a capacitor directly on the GPIO pin, the required ADC track time,  $t_{\text{track}}$ , needs to be adapted to the selected  $C_{LP,ACOMP}$  and series resistor values, see  $C_{LP}$  resp  $R_{LP}$  in table 79.

There is one special ACOMP configuration case that may not require any filter capacitor,  $C_{LP,ACOMP}$ , on the GPIO pin. When ACOMP is configured to disturbance-tolerant/SET-hard mode, it has a pulse rejection time,  $t_{\text{rej}}$  (about 30 ns, see section 57.9), which can be utilized here. The RC time constant on the GPIO pin must be short enough to give re-settling back to the right differential voltage polarity, with a margin of  $V_{IN,SW}$ , within the ACOMP minimum pulse rejection time,  $t_{\text{rej,min}}$ , see table 734. To achieve such fast re-settling on the GPIO pin, e.g., the total PCB-node and GPIO-pin capacitance may need to be in the order of 10pF and the signal source resistance may need to be in the range 100-1000  $\Omega$ . And keep in mind that the re-settling time also depends on how many time constants of settling that are needed to achieve the right polarity plus a margin of  $V_{IN,SW}$ . The GPIO-pin conditions for this



# LEON3FT Microcontroller

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ACOMP pulse-rejection solution might be more or less difficult to fulfill in different applications, anyhow, the solution might become useful in some application cases.

## 12.2.10 Access control

ADC, Pre-Amplifier and Analog MUX status and configuration can be accessed via registers.

# LEON3FT Microcontroller

## 12.3 Registers

The set of configuration and status registers available for each ADC controller is documented in table 83. The GR716 has 8 shared input pins (GPIO 37-44) to ADC0-2, and 8 input pins (GPIO 51-58) to ADC3. The 8 inputs to an ADC can be used as single-ended channels (up to 8) or differential channels (up to 4), or a mix of them in each ADC independently. Additionally, each ADC has one more input channel internally (differential): ADC0 has the temperature sensor (chapter 14), ADC1 has the core supply, ADC2 has the  $V_{REFBUF}$  output, and ADC3 has the PLL supply.

Table 83. ADC, Pre-Amplifier and Analog MUX status and control registers

APB address offset	Register
0x00	ADC control register (ACFG)
0x04	ADC status register (ASTS)
0x08	High range detection register (AHT)
0x0C	Low range detection register (ALT)
0x10	ADC Buffer SYNC Register 0 (ABSYNCO)
0x14	ADC Buffer Control Register 0 (ABCFG0)
0x18	ADC Buffer Sampling Control Register 0 (ABSAMPC0)
0x1C	ADC Buffer Status and Result 0 (ABSTS0)
0x20	ADC Buffer SYNC Register 1 (ABSYNCO1)
0x24	ADC Buffer Control Register 1 (ABCFG1)
0x28	ADC Buffer Sampling Control Register 1 (ABSAMPC1)
0x2C	ADC Buffer Status and Result 1 (ABSTS1)
0x30	ADC Buffer SYNC Register 2 (ABSYNCO2)
0x34	ADC Buffer Control Register 2 (ABCFG2)
0x38	ADC Buffer Sampling Control Register 2 (ABSAMPC2)
0x3C	ADC Buffer Status and Result 2 (ABSTS2)
0x40	ADC Buffer SYNC Register 3 (ABSYNCO3)
0x44	ADC Buffer Control Register 3 (ABCFG3)
0x48	ADC Buffer Sampling Control Register 3 (ABSAMPC3)
0x4C	ADC Buffer Status and Result 3 (ABSTS3)
0x50	ADC Debug register 0 (DBG0)
0x54	ADC Debug register 1 (DBG1)
0x58	ADC Debug register 2 (DBG2)

Table 84. 0x00 - ACFG - ADC, Pre-Amplifier and Analog MUX Control register

31	24	23	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
AC	TSET		AP	AC	ST	IE	TE	MD	RD	PB	R	AE	PE	AC	SQ	AC2	AS		
0xFF	0xFF		0	0	0	0	0	0	1	0	0	0	0	0	0	0	0		
rw	rw		rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw		

- 31: 24     ADC Scaler (AC) - The scaler reload bits for setting the ADC data rate. The ADC scaler is clocked by the system clock and decrement on each clock cycle. When the ADC scaler underflows it is reloaded with the value of this reload register and a tick is generated. The ADC clock is given by the System Frequency / (2\* (ACFG.AC +1)).
- 23: 15     ADC Timeout (TSET) - Timeout value
- 14         ADC Pre Bias (AP) - Pre-bias sign. 0 = default. 1 = invert sign
- 13         ADC Comparator invert (AC) - ADC Comparator invert
- 12         ADC Stop (ST) - ADC Stop

# LEON3FT Microcontroller

Table 84. 0x00 - ACFG - ADC, Pre-Amplifier and Analog MUX Control register

11	ADC Input enable (IE) - ADC Input Enable (override)
10	ADC Timeout enable (TE) - Timeout Enable
9	ADC Mode Gate (MD) - Mode Gating. Enabling sets ADC in differential differential mode during idle and pre-track.
8	ADC Round enable (RD) - Rounding of ADC result enable
7	ADC Pre-bias (PB) - Analog Pre-bias using 2C. 00 = none, b10 = positive, b01 = negative, b11 = none
6	Reserved
5	ADC Reference Enable (AE) - ADC (comparator and ref) Enable
4	ADC Amplifier Enable (PE) - Amplifier Enable
3	ADC Comparator invert 2 (AC2) - ADC Comparator invert 2. Setting this signal to '1' inverts the acomp value used for saving the digital result. Note, this only effect the stored digital value and not the control to the analog ADC itself.
2	ADC Synchronization (SQ) - Synchronization enable
1	ADC continuously (SC) - Sequence continuously
0	ADC Start (AS) - ADC Conversion start

Table 85. 0x04 - ASTS - ADC status register

31	30	29	28	27	26	25	24	23	0
IDLE	GIE	GWSEE	GWOFF	GTLO	GDLO	GALO	GAE	AD	
0	0	0	0	0	0	0	0	0	
r	r	r	r	r	r	r	r	r	

31	Indicates Idle State
30	Indicates some buffer channel has: IRQ – End Of conversion
29	Indicates some buffer channel has: WarnFlagSEE
28	Indicates some buffer channel has: WarnFlagOverflow
27	Indicates some buffer channel has: Trigger Lost
26	Indicates some buffer channel has: Data Lost(buffer written before read by user)
25	Indicates some buffer channel has: Conversion Lost(conversion cancelled by high prio request)
24	Indicates some buffer channel has: Data Valid
23 0	ADC digital output

Note 1: TBD

Table 86. 0x08 - AHT -ADC High Level detection register

31	20	19	0
Reserved		AHT	
0		-	
r		rw	

31: 20	RESERVED
19: 0	ADC High Level detection threshold (AHT) - An interrupt shall be generated if the sampled value is above the specified value in this register

Table 87. 0x0C - ALT -ADC Low Level detection register

31	20	19	0
Reserved		ALT	

# LEON3FT Microcontroller

Table 87. 0x0C - ALT -ADC Low Level detection register

0	-
r	rw

31: 20 RESERVED

19: 0 ADC Low Level detection threshold (ALT) - An interrupt shall be generated if the sampled value is below the specified value in this register

Table 88. 0x10 - ABSYNC - ADC Buffer Sync Register

31					20	19		16	15	14	13	12	9	8	7							0
								ACS	ESYNC	R	TSYNC	R		ASYNM		ASYNC						
								0x0	0x3	0	0x0	0		0x0		0x0						
								rw	rw	r	rw	r		rw		rw						

31: 20 Reserved.

19: 16 ADC Channel select

		<u>if ABCFG.AM=1</u>	<u>if ABCFG.AM=0</u>
	b0000	- ADC0	- ADC0-ADC1
	b0001	- ADC1	- ADC1-ADC0
	b0010	- ADC2	- ADC2-ADC3
	b0011	- ADC3	- ADC3-ADC2
	b0100	- ADC4	- ADC4-ADC5
	b0101	- ADC5	- ADC5-ADC4
	b0110	- ADC6	- ADC6-ADC7
	b0111	- ADC7	- ADC7-ADC6
	b1000	- + TEMPERATURE/Core Voltage/VREFBUF	-
	b1001	- - TEMPERATURE/Core Voltage/VREFBUF	-

15 Synchronization trigger level (ESYNC) - Select rising or falling edge for Edge mode, and high or low level for Level mode

14 Reserved

13 Synchronization trigger mode (TSYNC) - Select Edge or level trigger mode

12: 9 Reserved

8 Synchronization trigger mask (ASYNM) - Mask selected external trigger

7: 0 Synchronization trigger (ASYNC) - Select external trigger:

127: 126	-	Not Used. When selected trigger input level is always '0'
125: 122	-	Synchronize ADC to trigger on DAC0, DAC1, DAC2 or DAC3 interrupt
121: 118	-	Synchronize ADC to trigger on Timers from RTA0 and RTA1
117: 32	-	Synchronize ADC to trigger on GPIO 61 to 54 (31 synchronize to GPIO 61, 30 to 60 etc.)
31: 16	-	Synchronize ADC to trigger on GPIO 15 to 0
15: 8	-	Synchronize ADC to Timer unit 1
7: 0	-	Synchronize ADC to Timer unit 0

Table 89. 0x14 - ABCFG - ADC Buffer Control Register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	R	R	IC	MH	ML	ME	AM	AB	AG	MDE	R	R	HP	TT																	
0	0	0	0	0	0	0	0	1	0x0	0x0	0	0	0	0x63																	

# LEON3FT Microcontroller

Table 89. 0x14 - ABCFG - ADC Buffer Control Register

r	r	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r	r	r/w	r/w									
---	---	---	-----	-----	-----	-----	-----	-----	-----	---	---	-----	-----	--	--	--	--	--	--	--	--	--

- 31: 29 Reserved.
- 28 ADC Buffer Interrupt Auto Clear (IC) - IRQ auto-clear
- 27 ADC Buffer Interrupt High Level (MH) - IRQ Mask High Level Detection
- 26 ADC Buffer Interrupt Low Level (ML) - IRQ Mask Low Level Detection
- 25 ADC Buffer Interrupt End of Conversion (ME) - IRQ Mask End of Conversion
- 24 ADC Buffer amplifier gain (AM) - Single-ended mode enabled
- 23 ADC Buffer amplifier bypass (AB) - Amplifier bypass
- 22: 21 ADC Buffer amplifier gain (AG) - ADC amplifier gain
- 20: 19 ADC Buffer mode (MDE) - ADC Buffer Mode
- 18: 17 Reserved
- 16 High Prio (HP) - Buffer has high priority. Enable this bit will interrupt and stop other buffers
- 15: 0 Track Time (TT) - Set Track time for buffer

Table 90. 0x18 - ABSAMPC - ADC Buffer Sampling Control Register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R												ASH						AO													
0												0x0						0x0													
r												r/w						r/w													

- 31: 12 Reserved.
- 12: 8 ADC Shift (ASH)
- 7: 0 ADC Oversampling (AO)

Table 91. 0x1C - ABSTS - ADC Buffer status register

31	30	29	28	27	26	25	24	23	22	21	20	19	0			
TO	IH	TRG	IE	TRG	WSEE	WOF	TLO	DLO	CLO	WST	AE	ASQ				
0	0	0	0	0	0	0	0	0	0	0	0	0				
wc	wc	wc	wc	r	wc	wc	wc	wc	wc	wc	r	wc	r			

- 31 Timeout
- 30 IRQ – High Level Detection
- 29 IRQ – Low Level Detection
- 28 IRQ – End Of conversion
- 27 Sync\_event. Indicates a trigger on the specific channel occurred and conversion not completed (could be queued as well)
- 26 WarnFlagSEE
- 25 WarnFlagOverflow
- 24 Trigger Lost
- 23 Data Lost(buffer written before read by user)
- 22 Conversion Lost(conversion cancelled by high prio request)
- 21 Waiting to start
- 20 Data Valid
- 19 0 ADC Buffer digital output

# LEON3FT Microcontroller

## 13 LDO

### 13.1 Overview

The internal LDO supports single 3.3 V supply for the GR716 microcontroller. In single supply mode, the internal LDO supplies 1.8 V to  $V_{DD\_CORE}$  internally. In dual supply mode, this LDO is not in use, and  $V_{DD\_CORE}$  needs to be supplied by external 1.8 V supply from PCB. See figure 9 for LDO connections, and section 57.12 for LDO electrical specifications.

In addition to the core current consumption, in single supply mode the internal LDO can also supply other 1.8 V loads on PCB. To use this feature, the other PCB loads are simply connected directly between the  $V_{DD\_CORE}$  and GND planes on PCB.

### 13.2 Operation

#### 13.2.1 System overview

The internal LDO provides the digital core with a regulated  $V_{DD\_CORE}$  of 1.8 V, where the LDO output is directly connected to  $V_{DD\_CORE}$  internally. The LDO needs a 3.3 V input supply connected to  $V_{DD\_LDO}$ , and increases the internal power dissipation with the load current times the LDO voltage drop. Therefore, the maximum junction temperature should be carefully checked in applications where the core current, and consequently also the LDO current, can become high. Instead of using the internal LDO, the  $V_{DD\_CORE}$  supply pins can be supplied directly from a 1.8 V supply on PCB, and  $V_{DD\_LDO}$  should then be connected to  $V_{DD\_CORE}$ .

#### 13.2.2 Detailed description

When the internal LDO is in use, i.e., single supply mode, the core supply current is drawn from the 3.3 V PCB supply into  $V_{DD\_LDO}$ , and flows through the LDO and then internally connected to  $V_{DD\_CORE}$ . Even though this LDO and connection to  $V_{DD\_CORE}$  are internal, there must still be external decoupling capacitors connected to the  $V_{DD\_CORE}$  supply pins on PCB, see below. For further recommended operating conditions for the LDO, see section 57.2.

The LDO will cause additional internal power dissipation, equal to the LDO average current times the voltage drop from  $V_{DD\_LDO}$  to  $V_{DD\_CORE}$ , which will further increase the GR716 junction temperature. Therefore, when running the core logic such that the core current, and thereby also the LDO current, is high, it is critical to carefully check that the maximum allowed junction temperature is never exceeded in the thermal situation at hand. This should be checked in all application implementations with the GR716 microcontroller, but it is especially important when the LDO is in use at the same time as core current can be high.

In dual supply mode, the  $V_{DD\_CORE}$  pins are directly fed with 1.8 V regulated supply voltage from PCB, instead of using the internal LDO. In this case, the  $V_{DD\_LDO}$  supply pins must *not* be connected to any low-impedance node other than  $V_{DD\_CORE}$ . Another possibility is to leave the  $V_{DD\_LDO}$  pins open (floating), but in space environment applications it is recommended to connect them to  $V_{DD\_CORE}$ .

In regard to decoupling on  $V_{DD\_CORE}$ , it should be done similarly whether the LDO is in use or not. It should always be in the order of 10nF ceramic capacitor per supply pin pair, and a larger, well damped capacitance bank somewhere nearby the GR716 package in the PCB layout. See section 57.2 for further details. When the LDO is in use, decoupling on the  $V_{DD\_LDO}$  pins should be done similarly, i.e., in the order of 10nF per pin pair, and a larger, well damped capacitance bank somewhere nearby (which can be common to other 3.3V loads on PCB, to be decided at convenience by the PCB designer).

### 13.2.3 Pulsed load currents

The maximum average current rating for the LDO output is  $700\text{mA}_{\text{DC}}$ , and repetitive pulse load currents up to  $1.1\text{A}_{\text{Peak}}$  are allowed for a limited pulse length, see section 57.2. Note that the LDO output current is the sum of the internal core current and all external load currents connected to the  $V_{\text{DD\_CORE}}$  net on PCB. This current sum cannot be measured, since the LDO output is connected internally to the core. However, since the quiescent current of the LDO is negligible (typically  $2\text{mA}$ ) compared to the LDO maximum ratings, this current sum can be measured on the  $V_{\text{DD\_LDO}}$  pins ( $I_{\text{DD\_LDO}}$ ) accurately enough, and will in this discussion be regarded equal to the total LDO load current.

The LDO regulator does not guarantee full performance on the LDO output voltage ( $V_{\text{DD\_CORE}}$ ) for load currents above  $0.7\text{A}$ , so the load current that exceeds  $0.7\text{A}$  will be called ‘over-current’ here. Hence, to fully guarantee the output voltage performance during current pulses up to  $1.1\text{A}_{\text{Peak}}$ , the pulse duration needs to be short enough for charge in the external decoupling capacitors to handle the pulse with acceptable voltage drop.

The recommended decoupling on the LDO output ( $V_{\text{DD\_CORE}}$ ) is  $2\times (100\mu\text{F}+0.1\Omega)$  for this LDO, see section 57.2. Hence, a  $0.4\text{A}$  over-current pulse ( $1.1\text{A}-0.7\text{A}=0.4\text{A}$ ), with duration in the order of  $10\mu\text{s}$ , would give an additional voltage drop of up to  $0.4\text{A}\cdot 50\text{m}\Omega+0.4\text{A}\cdot 10\mu\text{s}/200\mu\text{F} = 20\text{mV}+20\text{mV} = 40\text{mV}$ , if the whole over-current pulse would be drawn from the decoupling capacitors only. For a  $0.1\text{A}$  over-current pulse, with duration in the order of  $100\mu\text{s}$ , it would be a voltage drop of  $0.1\text{A}\cdot 50\text{m}\Omega+0.1\text{A}\cdot 100\mu\text{s}/200\mu\text{F} = 5\text{mV}+50\text{mV} = 55\text{mV}$ . But for such a long pulse time, the LDO regulator would compensate for the majority of the pulse drop, resulting in a voltage drop of significantly less than  $40\text{mV}$ .

Whether the above added voltage drops are acceptable on the  $V_{\text{DD\_CORE}}$  supply rail or not will depend on the application. For most digital-load applications, such as the microcontroller core logic, they would be highly likely to work perfectly well. Note however that the average load current,  $I_{\text{DD\_LDO,ave}}$ , must stay below  $0.7\text{A}$ , to guarantee full DC-regulation performance and maintain device long-term reliability.

Typical applications where pulsed load design can be utilized are in design of real-time software cycles in RTA and LEON3 executions. For example, typical execution times for RTA control-loop routines for DC/DC converters can be in the order of  $1-10\mu\text{s}$ , with cycle repetition times in the range of  $2-20\mu\text{s}$ . According to above, up to  $0.4\text{A}$  over-current pulses can be drawn for up to about  $10\mu\text{s}$ , which covers the maximum execution time and maximum current consumption for an RTA, see section 57.3. In the software implementation, note that to take full advantage of reduced current consumption during the idle time in the cycle, it needs to be put in true halt/idle state and not continue to execute NOP, etc. The RTAs, therefore, have support for fast start up from halt/idle state.

# LEON3FT Microcontroller

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## 14 Temperature Sensor

### 14.1 Overview

There is an integrated temperature sensor on the GR716 microcontroller, which can be used to supervise the die temperature.

### 14.2 Operation

#### 14.2.1 System overview

The on-chip temperature sensor can be sampled via the internal ADC. It is not accessible externally.

#### 14.2.2 Detailed description

The temperature-sensor is measured by the internal ADC in the same way as any other analog MUX channel. The sensor output signal is a linear voltage versus temperature in Kelvin. The junction temperature value in degree Celsius can be calculated according to the following formula:

$$TEMP = TBD$$

Here, formula constants should be calibrated, e.g. at room temperature, to achieve good accuracy from this sensor. Without calibration the tolerance could be up to  $\pm TBD^{\circ}\text{C}$ .

For automatic output threshold detection, e.g. used as over-temperature protection, the level detection feature in the internal ADC can be used to get an alarm (interrupt) when the temperature is above/below a configured level. The alarm (interrupt) is not used in any internal hardware block, so if e.g. an over-temperature protection is desired the user needs to take adequate actions to handle the interrupt in the user system application.

#### 14.2.3 Access control

The temperature sensor is always enabled and the output can be sampled with the ADC interface.



# LEON3FT Microcontroller

## 15 DAC

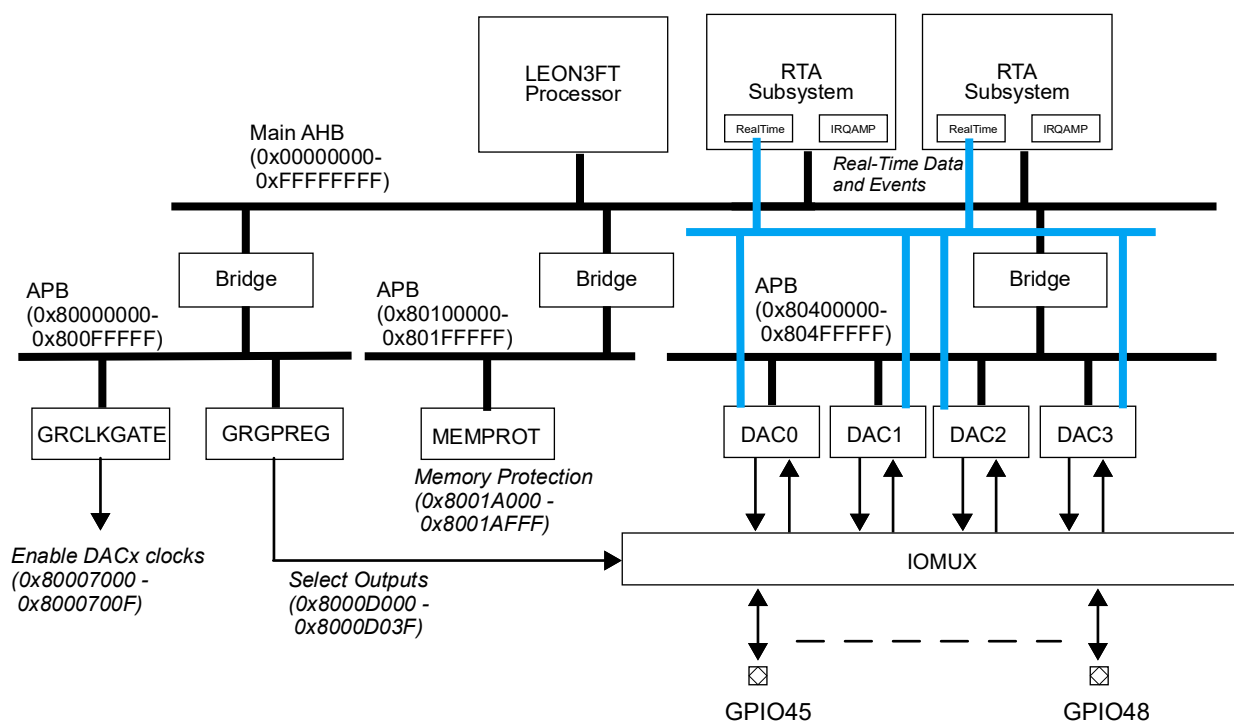
### 15.1 Overview

The GR716B has 4 separate 12 bit Digital-to-Analog Converter (DAC) converters and 4 separate DAC control units. Each Digital-to-Analog Converter (DAC) is a 12 bit resolution DAC. The digital core logic provides a register control and status interface via registers for each DAC. The digital interface also provides more complex control logic in order to synchronize the DAC output to e.g. timers in the LEON3FT microcontroller.

The DAC control units are located on APB bus in the address range from 0x80408000 to 0x8040BFFF. See DAC converters and DAC control units connections in the next drawing. The figure shows the memory locations and functions used for DAC configuration and control.

Each DAC control unit can generate an output ramp. Output ramp generation configuration can be accessed instantaneously on the *Real-time Data and Event* bus shown in figure 21 from the RTA.

Figure 21. GR716B DAC bus and pin connection



The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable individual DAC units. The unit **GRCLKGATE** can also be used to perform reset of individual DAC units. Software must enable clock and release reset described in section 27 before DAC configuration and transmission can start.

External IO selection per DAC unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

Each **DACx** unit controls its own external pin and has a unique AMBA address described in chapter 2.10. DAC units 0, 1, 2 and 3 have identical configuration and status registers. Configuration and status registers are described in section 15.3.

The system can be configured to protect and restrict access to individual DAC units in the **MEMPROT** unit. See section 47 for more information.

# LEON3FT Microcontroller

## 15.2 Operation

### 15.2.1 System overview

There are four independent DAC blocks at 12bit/3MSps with full analog performance, and digital ramp generation support upto 25 MS/s. They have sourcing-current single-ended outputs, typically to be loaded by virtual grounds generated by op-amps on PCB, or by passive impedances connected to PCB ground providing the output voltages directly across these impedances. These four blocks are supplied by VDDA\_DAC and VSSA\_DAC. In the same way as for the ADC, it is enough to provide really good decoupling at high frequencies (>~1MHz).

Note that the DAC full scale current is proportional to the current through the external RREF, and 5.11kohm gives a full scale current of 4.0mA nominally.

### 15.2.2 Detailed description

Each DAC will convert a 12 bit register to an analog output. The register is accessible via the APB register interface the digital DAC interface provides. The conversion from the 12 bit register can take affect immediately or when a selected trigger event occurs. The DSEQ.SQ bit determines the DAC mode. When DSEQ.SQ is set to '0' the conversion will take affect immediately and when DSEQ.SQ is set to '1' the conversion will take affect on the next trigger event selected in the DSYNC register.

Triggers can be set to synchronize outputs from the DAC. When triggers are used the DAC output level or value will not be updated or changed until an event has occurred on the selected trigger. Trigger sources includes GPIOs, timer units and PWM ticks. The trigger type is configurable to edge (rising, falling or both) or level (high or low). There is a Trigger synchronization feature that can be used to synchronize the DAC clock to the trigger source. This is useful to get a known time relative to the trigger when data is updated on the package pin.

In trigger mode the output value in register DOUT can be updated at anytime without affecting the DAC output (the package pin). The value in the 12 bit register is directly forwarded to the analog DAC when an trigger event occur.

The speed of the conversion can be in the range from 1Ksps to 3Msps. The conversion rate is set by the internal DAC scaler register field DCFG.DS.

Interrupt can be enabled to be generated when the DAC output is updated with configurable delay. Option for auto-clear and masking is supported.

Power down of the DAC is controlled via register.

Slew rate control can be enabled for system with sampling conversion rate up to 50Ksps. Enabling slew rate control will limit the DAC output current change and improve noise on the output. Slew rate control is enabled with register field DCFG.DD.

### 15.2.3 DAC output example

To enable DAC and direction conversation of the register use the following steps:

```

DCFG.DE = 8           // Enable DAC scaler
DCFG.DS = 0x1F4      // Set DAC scaler
DOUT = 1              // DAC digital output value
    
```

TABLE 92. Example of direction conversion of value 0xFF using DAC0

Address	Data	Description
---	---	
0x80408004	0x000000FF	DAC0 - Output Value
0x80408000	0x01FCC001	DAC0 - Configuration (Scaler, Mode, Enable)
---	---	

# LEON3FT Microcontroller

## 15.2.4 Real-time data and event bus

Configuration register for DAC 0, 1, 2 and 3 can be accessed instantaneously on the *Real-time Data and Event* bus.

## 15.2.5 Ramp generation

TBD

## 15.2.6 Access control

The integrated DAC is controlled via APB registers

## 15.3 Registers

Table 93. DAC control registers

APB address offset	Register
0x00	DAC Control register
0x04	Output register
0x08	Sequence control register
0x0C	Sequence synchronization register
0x14	Interrupt register
0x18	Interrupt mask register
0x1C	Ramp generation control register
0x20	Ramp generation start and stop register
0x24	Ramp start
0x28	Ramp end

Table 94. 0x00 - DCFG - DAC Control register

31	16	15	5	4	3	2	1	0
DS	Reserved		DC	DTS	R	DD	DE	
0x01F4	0		1	0	0	0	0	
rw	r		rw	r	r	rw	rw	

- 31: 16 DAC Scaler Divider (DS) - The scaler reload bits for setting the DAC data rate. The DAC scaler is clocked by the system clock and decrement on each clock cycle. When the DAC scaler underflows it is reloaded with the value of this reload register and a tick is generated. The DAC clock is given by the System Frequency / (2\* (DCFG.DS +1)).
- 15: 5 Reserved
- 4 DAC Conversion interrupt delay (DC) - When this signal is set the IRQ is generated simultaneously as the package pin is updated with the DAC output data (DOUT). Disable this signal will generate the IRQ one DAC CLK period prior to the package pin is updated.
- 3 DAC Trigger Synchronize mode (DTS). Enable this signal generates the DAC clock in phase with the trigger. This feature is only supported for Sequence synchronization mode (SQ = 1) and requires the scaler (DS) to be set to 5 or higher. Set the DTS bit at the same time as SQ is cleared will turn off the DAC CLK.  
Using this feature requires a certain sequence for proper function.
  - 1) Set DAC Enable (DE)
  - 2) Clear SQ bit and set DTS bit
  - 3) Set SQ bit
 When the next trigger is generated, the DAC CLK will be generated in phase with the trigger. With this setting the package pin is updated with the DAC output data (DOUT) value two DAC CLK periods after the trigger.
- 2 Reserved

# LEON3FT Microcontroller

Table 94. 0x00 - DCFG - DAC Control register

- 1 DAC DEM enable (DD) - The DAC support two operation modes:
- without DEM: data rate can change at maximum of 3Mhz data rate. An external filter at 1Mhz should be employed.
  - with DEM: data rate can change at division of 50Khz data rate. Other data rates will show drop in performance. A first order or filtering at 58.6khz must be employed to suppress switching artifacts of the DEM.
- 0 DAC Enable (DE) - Enable DAC. To power down the DAC set this bit to 0.  
Note that the DAC output is enabled when the DE bit is set. To avoid undesirable behaviour assure all other configurations are updated prior to setting the DE bit.

Table 95. 0x04 - DOUT - DAC output register

31		12	11	0
	R			DOUT
	0			0x000
	r			rw

- 31: 12 Reserved
- 11: 0 DAC Digital output (DOUT) - DAC Digital unsigned output. The output data on the package pin is updated with the DAC Digital output value at least 1 DAC CLK period after it has been updated. For exact timing, use the DAC Trigger Synchronize mode (DTS) as specified in the DCFG register.

Table 96. 0x08 - DSEQC - DAC Sequence Control register

31	30	28	27	25	24	23	22	0
SQ	Reserved	AC	ESYNC	TSYNC				Reserved
0	0	0	0x3	0				0
rw	r	rw	rw	rw				r

- 31 SQ: Sequence synchronization enable. The output sequence for the DAC will be synchronized to synchronization source selected in register DSYNC
- 30: 28 Reserved
- 27 Auto clear interrupt (AC). This feature can be used to clear automatic clear pending interrupt.
- 25: 24 ESYNC. Defines if the synchronization trigger should occur on rising/falling or high/low level. This signal should be set together with TSYNC
- b00 - Falling edge if TSYNC = 0; Low level if TSYNC = 1
- b01 - Rising or falling edge if TSYNC = 0; High and low if TSYNC = 1
- b10 - Rising or falling edge if TSYNC = 0; High and low if TSYNC = 1
- b11 - Rising edge if TSYNC = 0; High level if TSYNC = 1
- 23 TSYNC. Defines if the synchronization trigger should be of edge or level type. Clear this signal gives trigger on edge. Set this signal gives trigger on level. This signal should be set together with ESYNC. Trigger source is set by ASYNC register.
- 22: 0 Reserved

Table 97. 0x0C - DSYNC - DAC Sequence Synchronization register

31		10	9	6	5	0
	Reserved			DTSD		SYNC
	0			0x4		0
	r			rw		rw

# LEON3FT Microcontroller

Table 97. 0x0C - DSYNC - DAC Sequence Synchronization register

31: 10	Reserved
9: 6	DAC Trigger Synchronization Delay (DTSD). The value define the number of system clock cycles to wait after a trigger before starting the DAC clock generation. This signal is used together with the DTS signal to set the DAC clock is in phase with the trigger source. This parameter needs to be set together with the ESYNC and TSYNC parameters.
5: 0	Synchronization trigger (SYNC) - Select the trigger
63: 48	- <u>TBD</u>
47: 40	- Synchronize to PWM1 tick 7 downto 0
39: 32	- Synchronize to PWM0 tick 7 downto 0
31: 24	- Synchronize DAC to trigger on GPIO 61 to 54 (31 synchronize to GPIO 61, 30 to 60 etc.)
23: 16	- Synchronize DAC to trigger on GPIO 7 to 0 (23 synchronize to GPIO 7, 22 to 6 etc.)
15	- Synchronize DAC to Timer unit 1 counter 6
14	- Synchronize DAC to Timer unit 1 counter 5
13	- Synchronize DAC to Timer unit 1 counter 4
12	- Synchronize DAC to Timer unit 1 counter 3
11	- Synchronize DAC to Timer unit 1 counter 2
10	- Synchronize DAC to Timer unit 1 counter 1
9	- Synchronize DAC to Timer unit 1 counter 0
8	- Synchronize DAC to Timer unit 1 scaler tick
7	- Synchronize DAC to Timer unit 0 counter 6
6	- Synchronize DAC to Timer unit 0 counter 5
5	- Synchronize DAC to Timer unit 0 counter 4
4	- Synchronize DAC to Timer unit 0 counter 3
3	- Synchronize DAC to Timer unit 0 counter 2
2	- Synchronize DAC to Timer unit 0 counter 1
1	- Synchronize DAC to Timer unit 0 counter 0
0	- Synchronize DAC to Timer unit 0 scaler tick

Table 98. 0x14 - DINT - DAC Interrupt Register

31	1	0
Reserved	EI	
0	0	
r	wc	

- 31: 1 Reserved
- 0 Interrupt for DAC End of conversion (EI)

Table 99. 0x18 - DMASK - DAC Interrupt Mask Register

31	1	0
Reserved	EM	
0	0	
r	rw	

- 31: 1 Reserved
- 0 Interrupt Mask for DAC End of conversion (EM)

# LEON3FT Microcontroller

Table 100. 0x1C - DRFG - DAC Ramp Configuration register

31	16 15	8 7	0
DIVCLK	DELAY	STEP	
0x0	0	0	
rw	rw	rw	

- 31: 16 DAC Ramp Divisor Clock (DIVCLK) - The ramp scaler reload bits for setting the DAC ramp data rate. The DAC ramp scaler is clocked by the system clock and decrement on each clock cycle. When the DAC ramp scaler underflows it is reloaded with the value of this divreg register and a tick is generated to update the output ramp value
- 15: 8 DAC Ramp Delay Start (DELAY) - Delay start of new ramp DELAY system clock cycles from trigger or start.
- 7: 0 DAC Step (STEP) - Ramp step which DAC output. Step can be in the range from -127 to +128.

Table 101. 0x20 - DRCTRL - DAC Ramp control register

31	6 5 4 3 2 1 0
Reserved	M A T K EN
0	0 0 0 0 0
r	rw rw rw rw rw

- 5: 4 DAC Ramp Mode (M) - Select ramp mode
  - 0x0 - Single ramp mode, ramps DAC output value from configured ramp start to ramp stop in steps of DRFG.STEP.
  - 0x1 - Triangle wave mode, ramps DAC output value from configured ramp start to ramp stop in steps of DRFG.STEP.
  - 0x2 - Sawtooth wave mode, ramps DAC output value from configured ramp start to ramp stop in steps of DRFG.STEP.
- 3 DAC Alarm Mode (A) - Enable Alarm output when DAC output value reach max or min output value.
- 2 DAC Trig Mode (T) - Select scaler mode or external trigger mode. In scaler mode DAC output value will be updated when DAC scaler is reloaded (DRFG.DIVCLK). In external trigger mode DAC output is updated when trigger selected by DSYNC
- 1 DAC Kick (K) - Update RAMP generator with configuration values from DAC RAMP configuration register DRCF.
- 0 DAC Ramp Enable (E) - Enable DAC RAMP mode

Table 102. 0x24 - RSTART - DAC ramp start output register

31	12 11	0
R	START	
0	0x000	
r	rw	

- 31: 12 Reserved
- 11: 0 DAC ramp start output (DOUT) - Digital ramp start value

# LEON3FT Microcontroller

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Table 103. 0x28 - REND - DAC ramp end output register

31		12 11	0
	R		END
	0		0x000
	r		rw

31: 12    Reserved

11: 0     DAC ramp end output (DOUT) - Digital ramp end value

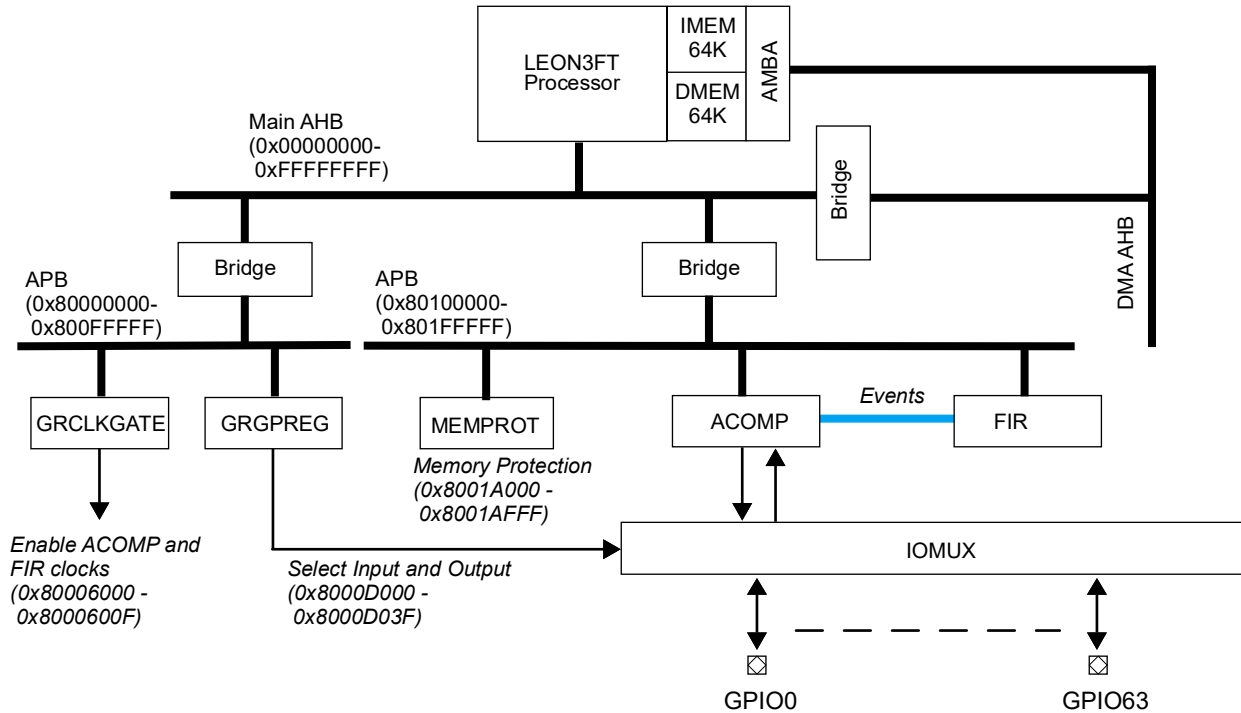
# LEON3FT Microcontroller

## 16 Fast Analog Comparator (ACOMP) and filter (FIR)

The GR716B microcontroller contains 20 Fast Analog comparator units (ACOMP) units. Each ACOMP unit has a unique AMBA address described in section 2.10 and is connected to a unique pair of analog input pins as illustrated in figures 10, 11, and 12 in section 2.3.

The Analog comparator units (ACOMP) are located on APB bus in the address range from 0x80108000 to 0x80108FFF. See ACOMP unit connections in the next drawing. The drawing picture memory locations and functions used for ACOMP configuration and control.

Figure 22. GR716B ACOMP bus and pin connection



The secondary clock gating unit **GRCLKGATE** described in section 28 is used to enable/disable the ACOMP and FIR unit. The unit **GRCLKGATE** can also be used to perform reset of the ACOMP and FIR units. Software must enable clock and release reset described in section 28 before ACOMP and FIR configuration and transmission can start.

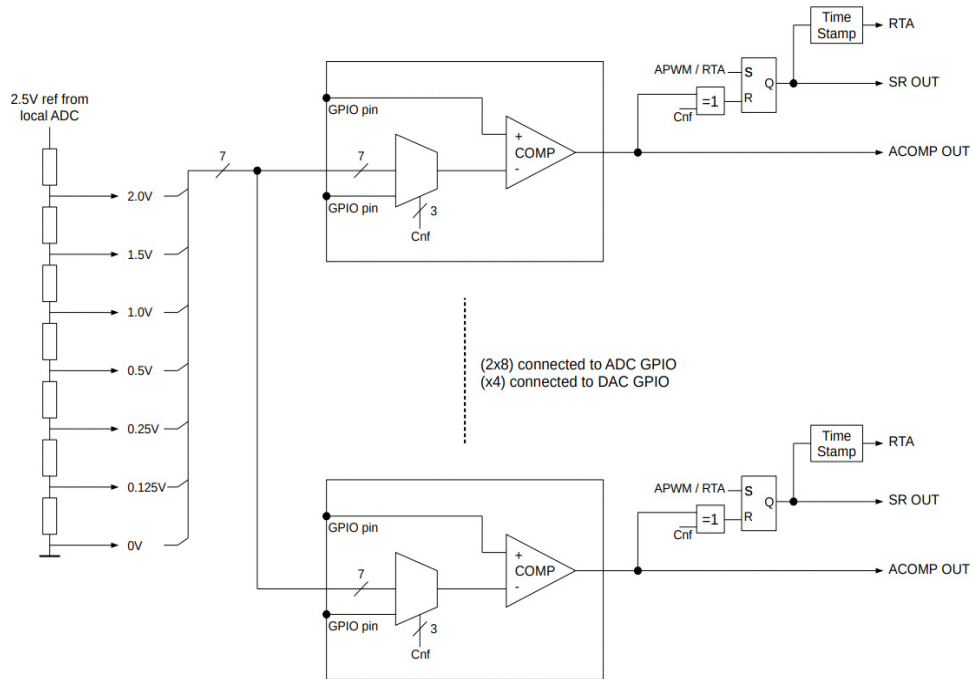
System can be configured to protect and restrict access to ACOMP units in the **MEMPROT** unit. See section 47 for more information.

### 16.1 Overview (TBD)

There will be one analog comparator connected to each of the 16 ADC input pins and to each of the 4 DAC output pins; this will be the comparator plus input. The analog comparator should be configurable to fix-voltage trig levels; this will be the comparator minus input. The trig levels are [mV]: 0, 125, 250, 500, 1000, 1500, 2000. Or the comparator minus input can be configured to another package pin (not same pin as the plus input).



# LEON3FT Microcontroller



Each analogue comparator can have its output configured to the input of the following function:

- Switching power and power application to provide PWM peak control
- General FIR filter for latch-up detection application FIR blocked described in this section

The FIR input can be configured to be connected to ACOMP output, and other digital signal sources. This filter will have 27 binary taps, and the input signal is binary with binary tap configuration, see figure 23.

The general 27 tap FIR filter with 1 bits per tap can implement a window function and applications areas are:

- Flexible programmable latch-up detectors
- General FIR filters
- Flexible patterns recognition in communications, sensors, etc
- Continuous background-monitoring with alarm trig on wave patterns, sensors, etc.

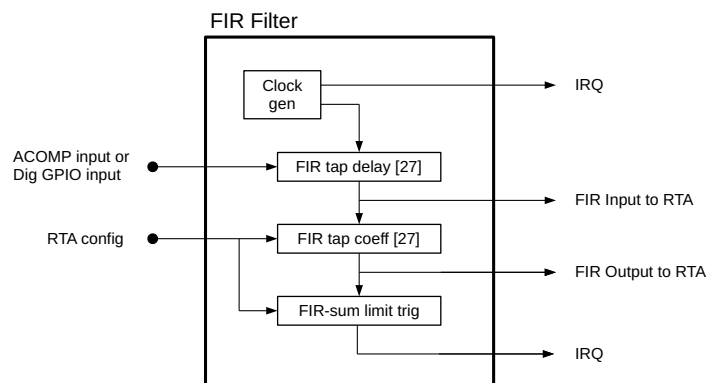


Figure 23. Filter structure of FIR

# LEON3FT Microcontroller

## 16.2 Operation

TBD

## 16.3 Registers

The core is programmed through registers mapped into APB address space.

Table 104. ACOMP registers

APB address offset	Register
0x81007000	ACOMP Status register
0x81007004	ACOMP Interrupt register
0x81007008	ACOMP Mask register
0x8100700C	ACOMP Interrupt Level trigger register
0x81007010	ACOMP Configuration register 0 (ACOMPCFG0)
0x81007014	ACOMP Configuration register 1 (ACOMPCFG1)
0x81007018	ACOMP Configuration register 2 (ACOMPCFG2)
0x8100701C	ACOMP Configuration register 3 (ACOMPCFG3)
0x81007020	ACOMP Configuration register 4 (ACOMPCFG4)
0x81007024	ACOMP Configuration register 5 (ACOMPCFG5)
0x81007028	ACOMP Configuration register 6 (ACOMPCFG6)
0x8100702C	ACOMP Configuration register 7 (ACOMPCFG7)
0x81007030	ACOMP Configuration register 8 (ACOMPCFG8)
0x81007034	ACOMP Configuration register 9 (ACOMPCFG9)
0x81007038	ACOMP Configuration register 10 (ACOMPCFG10)
0x8100703C	ACOMP Configuration register 11 (ACOMPCFG11)
0x81007040	ACOMP Reference Configuration register (ACOMPCFGREF1)
0x81007080	ACOMP Status register 0 (ACOMPSTS0)
0x81007084	ACOMP Status register 1 (ACOMPSTS1)
0x81007088	ACOMP Status register 2 (ACOMPSTS2)
0x8100708C	ACOMP Status register 3 (ACOMPSTS3)
0x81007090	ACOMP Status register 4 (ACOMPSTS4)
0x81007094	ACOMP Status register 5 (ACOMPSTS5)
0x81007098	ACOMP Status register 6 (ACOMPSTS6)
0x8100709C	ACOMP Status register 7 (ACOMPSTS7)
0x810070A0	ACOMP Status register 8 (ACOMPSTS8)
0x810070A4	ACOMP Status register 9 (ACOMPSTS9)
0x810070A8	ACOMP Status register 10 (ACOMPSTS10)
0x810070AC	ACOMP Status register 11 (ACOMPSTS11)
0x81008000	ACOMP Status register
0x81008004	ACOMP Interrupt register
0x81008008	ACOMP Mask register
0x8100800C	ACOMP Interrupt Level trigger register
0x81008010	ACOMP Configuration register 12 (ACOMPCFG12)
0x81008014	ACOMP Configuration register 13 (ACOMPCFG13)
0x81008018	ACOMP Configuration register 14 (ACOMPCFG14)
0x8100801C	ACOMP Configuration register 15 (ACOMPCFG15)
0x81008020	ACOMP Configuration register 16 (ACOMPCFG16)

Table 104. ACOMP registers

APB address offset	Register
0x81008024	ACOMP Configuration register 17 (ACOMPCFG17)
0x81008028	ACOMP Configuration register 18 (ACOMPCFG18)
0x8100802C	ACOMP Configuration register 19 (ACOMPCFG19)
0x81008030	ACOMP Reference Configuration register (ACOMPCFGREF2)
0x81008080	ACOMP Status register 12 (ACOMPSTS12)
0x81008084	ACOMP Status register 13 (ACOMPSTS13)
0x81008088	ACOMP Status register 14 (ACOMPSTS14)
0x8100808C	ACOMP Status register 15 (ACOMPSTS15)
0x81008090	ACOMP Status register 16 (ACOMPSTS16)
0x81008094	ACOMP Status register 17 (ACOMPSTS17)
0x81008098	ACOMP Status register 18 (ACOMPSTS18)
0x8100809C	ACOMP Status register 19 (ACOMPSTS19)
0x81208000	FIR 0 Status register
0x81208004	FIR 0 Interrupt register
0x81208008	FIR 0 Mask register
0x8120800C	FIR 0 Level trigger register
0x81208010	FIR 0 Configuration register 0 (FIRCFG0)
0x81208014	FIR 0 Configuration register 1 (FIRCFG1)
0x81208080	FIR 0 Status register 0 (FIRSTS0)
0x81208084	FIR 0 Status register 1 (FIRSTS1)
0x81209000 <sup>1)</sup>	FIR 1
0x8120A000 <sup>1)</sup>	FIR 2
0x8120B000 <sup>1)</sup>	FIR 3
0x8120C000 <sup>1)</sup>	FIR 4
0x8120D000 <sup>1)</sup>	FIR 5
0x8120E000 <sup>1)</sup>	FIR 6
0x8120F000 <sup>1)</sup>	FIR 7
0x8110A000	FIR Clock Generator Status register
0x8110A004	FIR Clock Generator Interrupt register
0x8110A008	FIR Clock Generator Mask register
0x8110A00C	FIR Clock Generator Interrupt Level trigger register
0x8110A010	FIR Clock Generator Configuration register 0 (FIRCLKCFG0)
0x8110A014	FIR Clock Generator Configuration register 1 (FIRCLKCFG1)
0x8110A080	FIR Clock Generator Status register 0 (FIRCLK1STS0)
0x8110A084	FIR Clock Generator Status register 1 (FIRCLKSTS1)

Note 1: Identical status and configuration register as "FIR 0"

# LEON3FT Microcontroller

## 16.3.1 ACOMP Status register

Table 105.0x00 - ACOMPSTAT - ACOMP Status register

31	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	C11	C10	C9	C8	C7	C6	C5	C4	C3	C2	C1	C0													
0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r

31: 24 Reserved

23: 0 Analog comparator outputs status (Cx) - Each analog comparator has 2 status bits for comparisons

## 16.3.2 ACOMP Interrupt Register

Table 106.0x04 - ACOMP\_IRQ - ACOMP Interrupt register

31	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	C11	C10	C9	C8	C7	C6	C5	C4	C3	C2	C1	C0													
0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc

31: 24 Reserved

23: 0 Analog comparator interrupt register (Cx)

## 16.3.3 ACOMP Mask Register

Table 107.0x08 - ACOMPMSK - ACOMP mask register

31	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	C11	C10	C9	C8	C7	C6	C5	C4	C3	C2	C1	C0													
0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

31: 24 Reserved

23: 0 Analog comparator mask register (Cx)

## 16.3.4 ACOMP Event Level Register

Table 108.0x08 - ACOMPLVL - ACOMP Interrupt level register

31	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R	C11	C10	C9	C8	C7	C6	C5	C4	C3	C2	C1	C0													
0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

31: 24 Reserved

23: 0 Analog comparator interrupt level register (Cx)

# LEON3FT Microcontroller

## 16.3.5 ACOMP Configuration Register

Table 109. ACOMP\_CFGx - ACOMP Configuration register 0 to 19

31		12	11	9	8	7	6	5	4	0
	R		REF	AR	PD	SE	CL		CNF	
	0		0	0	0	0	0		0	
	r		rw	rw	rw	rw	rw		rw	

- 31: 12      Reserved
- 11: 9      Select reference input for comparator:
  - 000b - From external GPIO
  - 001b - 0V (Ground)
  - 010b - 0.125V
  - 011b - 0.25V
  - 100b - 0.5V
  - 101b - 1.0V
  - 110b - 1.5V
  - 111b - 2.0V
- 8          Arm SR latch
- 7          Power down comparator
- 6          Set SR latch
- 5          Clear SR Latch
- 4: 0      Configure Latch
  - 4      Synchronization select
  - 3      Clear SR Dual latch
  - 2      Disable
  - 1:0    Select input

## 16.3.6 ACOMP Status Register

Table 110. ACOMP\_STSx - ACOMP Status register 0 to 19

31		0
	TIMESTAMP	
	0	
	r	

- 31: 0      Timestamp

## 16.3.7 FIR Status register

Table 111. 0x00 - FIRSTAT - FIR Status register

31		1	0
	R		COMP
	0		0x0
	r		r

- 31: 1      Reserved
- 0          FIR comparator (COMP)

## 16.3.8 FIR Interrupt Register

Table 112. 0x04 - FIRPIRQ - FIR Interrupt register

31		1	0
	R		COMP
	0		0x0

# LEON3FT Microcontroller

Table 112.0x04 - FIRPIRQ - FIR Interrupt register

	r	wc
--	---	----

- 31: 1      Reserved
- 0          FIR comparator (COMP)

## 16.3.9 FIR Mask Register

Table 113.0x08 - FIRMSK - FIR mask register

31	R	1	0
	0	COMP	
	r	0x0	
		rw	

- 31: 1      Reserved
- 0          FIR comparator (COMP)

## 16.3.10 FIR Event Level Register

Table 114.0x08 - FIRLVL - FIR Interrupt level register

31	R	1	0
	0	COMP	
	r	0x0	
		rw	

- 31: 1      Reserved
- 0          FIR comparator (COMP)

## 16.3.11 FIR Filter Configuration Register

Table 115.0x81208010 - FIRCFG0 - FIR configuration register 0

31	R	6	5	4	0
	0	XOR		SEL	
	r	0		0x0	
		rw		rw	

- 5          Enable XOR Output
- 4: 0      Filter coefficient for FIR filter. If filter coefficient is set '0' the filter is bypassed.
- 31- 16    Not Used
- 15        Select ACOMP input (13,15,15,17,17,19,19)
- 14        Select ACOMP input (12,14,14,16,16,18,18)
- 13        Select ACOMP input (8,9,9,10,10,10,11)
- 12        Select ACOMP input (1,2,3,5,5,7,7)
- 11        Select ACOMP input (0,2,2,4,4,6,6)
- 10- 1     Select GPIO input (3\*i+0) where i is the FIR filter number i = [0 .. 7]
- 7- 0      Select Output from APWG 0 to 7

# LEON3FT Microcontroller

## 16.3.12 FIR Filter coefficient Register 1

Table 116.0x81208014 - FIRCFG1 configuration register 1

31	27	26	0
R	COEF		
0	0		
r	rw		

26: 0 Filter coefficient for FIR filter. If filter coefficient is set '0' the filter is bypassed.

## 16.3.13 FIR Filter Status Register 0

Table 117.0x81208080 - FIRSTS0 configuration register 0

31	27	26	0
COMP	FILTER		
0x0	0x0		
rw	rw		

31: 27 Threshold register

26: 0 Current filter status

## 16.3.14 FIR Filter Status Register 1

Table 118.0x81208080 - FIRSTS1 configuration register 0

31	5	4	0
R	SUM		
0	0		
r	rw		

4: 0 Filter sum

# LEON3FT Microcontroller

## 16.3.15 FIRCLKCFG Status register

Table 119.0x00 - FIRCLKCFGSTAT - FIRCLKCFG Status register

31		10	9	8	7	6	5	4	3	2	1	0
	R	F7	F6	F5	F4	F3	F2	F1	F0	T1	T0	
	0	0	0	0	0	0	0	0	0	0	0	0
	r	r	r	r	r	r	r	r	r	r	r	r

- 31: 1 Reserved
- 9 FIR filter 7 Tick
- 8 FIR filter 6 Tick
- 7 FIR filter 5 Tick
- 6 FIR filter 4 Tick
- 5 FIR filter 3 Tick
- 4 FIR filter 2 Tick
- 3 FIR filter 1 Tick
- 2 FIR filter 0 Tick
- 1 FIR Sample clock Tick 1
- 0 FIR Sample clock Tick 0

## 16.3.16 FIRCLKCFG Interrupt Register

Table 120.0x04 - FIRCLKCFGPIRQ - FIRCLKCFG Interrupt register

31		10	9	8	7	6	5	4	3	2	1	0
	R	F7	F6	F5	F4	F3	F2	F1	F0	T1	T0	
	0	0	0	0	0	0	0	0	0	0	0	0
	r	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc

- 31: 1 Reserved
- 9 FIR filter 7 Tick
- 8 FIR filter 6 Tick
- 7 FIR filter 5 Tick
- 6 FIR filter 4 Tick
- 5 FIR filter 3 Tick
- 4 FIR filter 2 Tick
- 3 FIR filter 1 Tick
- 2 FIR filter 0 Tick
- 1 FIR Sample clock Tick 1
- 0 FIR Sample clock Tick 0

## 16.3.17 FIRCLKCFG Mask Register

Table 121.0x08 - FIRCLKCFGMSK - FIRCLKCFG mask register

31		10	9	8	7	6	5	4	3	2	1	0
	R	F7	F6	F5	F4	F3	F2	F1	F0	T1	T0	
	0	0	0	0	0	0	0	0	0	0	0	0
	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

- 31: 1 Reserved
- 9 FIR filter 7 Tick
- 8 FIR filter 6 Tick
- 7 FIR filter 5 Tick
- 6 FIR filter 4 Tick



# LEON3FT Microcontroller

Table 121.0x08 - FIRCLKCFGMSK - FIRCLKCFG mask register

5	FIR filter 3 Tick
4	FIR filter 2 Tick
3	FIR filter 1 Tick
2	FIR filter 0 Tick
1	FIR Sample clock Tick 1
0	FIR Sample clock Tick 0

## 16.3.18 FIRCLKCFG Event Level Register

Table 122.0x08 - FIRCLKCFGLVL - FIRCLKCFG Interrupt level register

31		10	9	8	7	6	5	4	3	2	1	0
	R	F7	F6	F5	F4	F3	F2	F1	F0	T1	T0	
	0	0	0	0	0	0	0	0	0	0	0	
	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	

31: 1	Reserved
9	FIR filter 7 Tick
8	FIR filter 6 Tick
7	FIR filter 5 Tick
6	FIR filter 4 Tick
5	FIR filter 3 Tick
4	FIR filter 2 Tick
3	FIR filter 1 Tick
2	FIR filter 0 Tick
1	FIR Sample clock Tick 1
0	FIR Sample clock Tick 0

## 16.3.19 FIRCLKCFG Configuration register 0 to 1

Table 123.0x08 - FIRCLKCFG - FIRCLKCFG Interrupt level register

31		0
	PERIOD	
	0	
	rw	

31: 0	FIR Filter Period (PERIOD) - Number of system clock periods
-------	---

## 16.3.20 FIRCLKSTS Status register 0 to 7

Table 124.0x08 - FIRCLKSTS - FIRCLKSTS Interrupt level register

31	27	26	0
SUM	FILTER		
0x0	0x0		
r	r		

31: 27	Filter sum
26: 0	Filter status

# LEON3FT Microcontroller

## 17 LEON3/FT - High-performance SPARC V8 32-bit Processor

### 17.1 Overview

LEON3 is a 32-bit processor core conforming to the IEEE-1754 (SPARC V8) architecture. It is designed for embedded applications, combining high performance with low complexity and low power consumption.

The LEON3 core has the following main features: 7-stage pipeline with Harvard architecture, hardware multiplier and divider, on-chip debug support and multi-processor extensions.

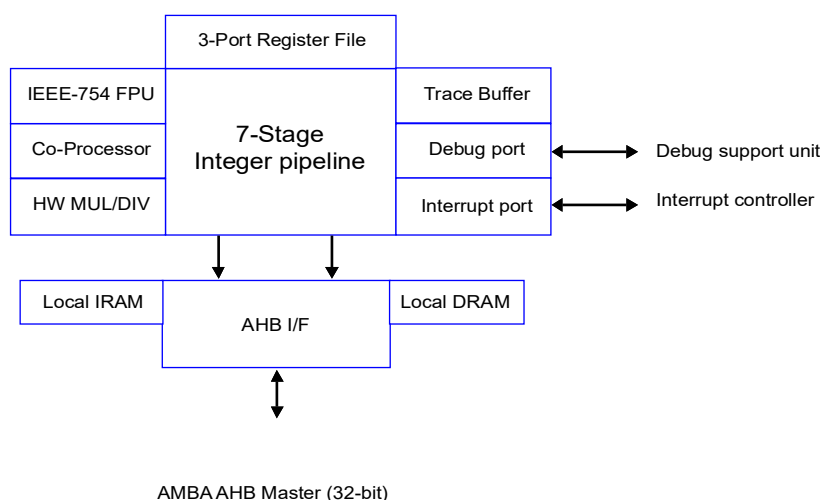


Figure 24. LEON3 processor core block diagram

#### 17.1.1 Integer unit

The LEON3 integer unit implements the full SPARC V8 manual, including hardware multiply and divide instructions. The number of register windows is 31. The pipeline consists of 7 stages with a separate local instruction and data interface (Harvard architecture).

#### 17.1.2 Floating-point unit and co-processor

The LEON3 integer unit provides interfaces for a floating-point unit (FPU). The floating-point processors execute in parallel with the integer unit, and does not block the operation unless a data or resource dependency exists.

#### 17.1.3 On-chip debug support

The LEON3 pipeline includes functionality to allow non-intrusive debugging on target hardware. To aid software debugging, 4 watchpoint registers can be enabled. Each register can cause a breakpoint trap on an arbitrary instruction or data address range. When the debug support unit is attached, the watchpoints can be used to enter debug mode. Through a debug support interface, full access to all processor registers is provided. The debug interfaces also allows single stepping, instruction tracing and hardware breakpoint/watchpoint control. An internal trace buffer can monitor and store executed instructions, which can later be read out via the debug interface.

# LEON3FT Microcontroller

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## 17.1.4 Interrupt interface

LEON3 supports the SPARC V8 interrupt model with a total of 15 asynchronous interrupts. The interrupt interface provides functionality to both generate and acknowledge interrupts.

## 17.1.5 AMBA interface

LEON3 implements an AMBA AHB master to load and store data. The interface is compliant with the AMBA-2.0 standard.

## 17.1.6 Power-down mode

The LEON3 processor core implements a power-down mode, which halts the pipeline until the next interrupt. The processor also supports clock gating during the power down period. A small part of the CPU is always awake and needs to run during power-down to check for wake-up conditions.

## 17.2 LEON3 integer unit

### 17.2.1 Overview

The LEON3 integer unit implements the integer part of the SPARC V8 instruction set. The implementation is focused on high performance and low complexity. The LEON3 integer unit has the following main features:

- 7-stage instruction pipeline
- 31 register windows
- Hardware multiplier
- Radix-2 divider (non-restoring)
- Static branch prediction
- Single-vector trapping for reduced code size

Figure 25 shows a block diagram of the integer unit.

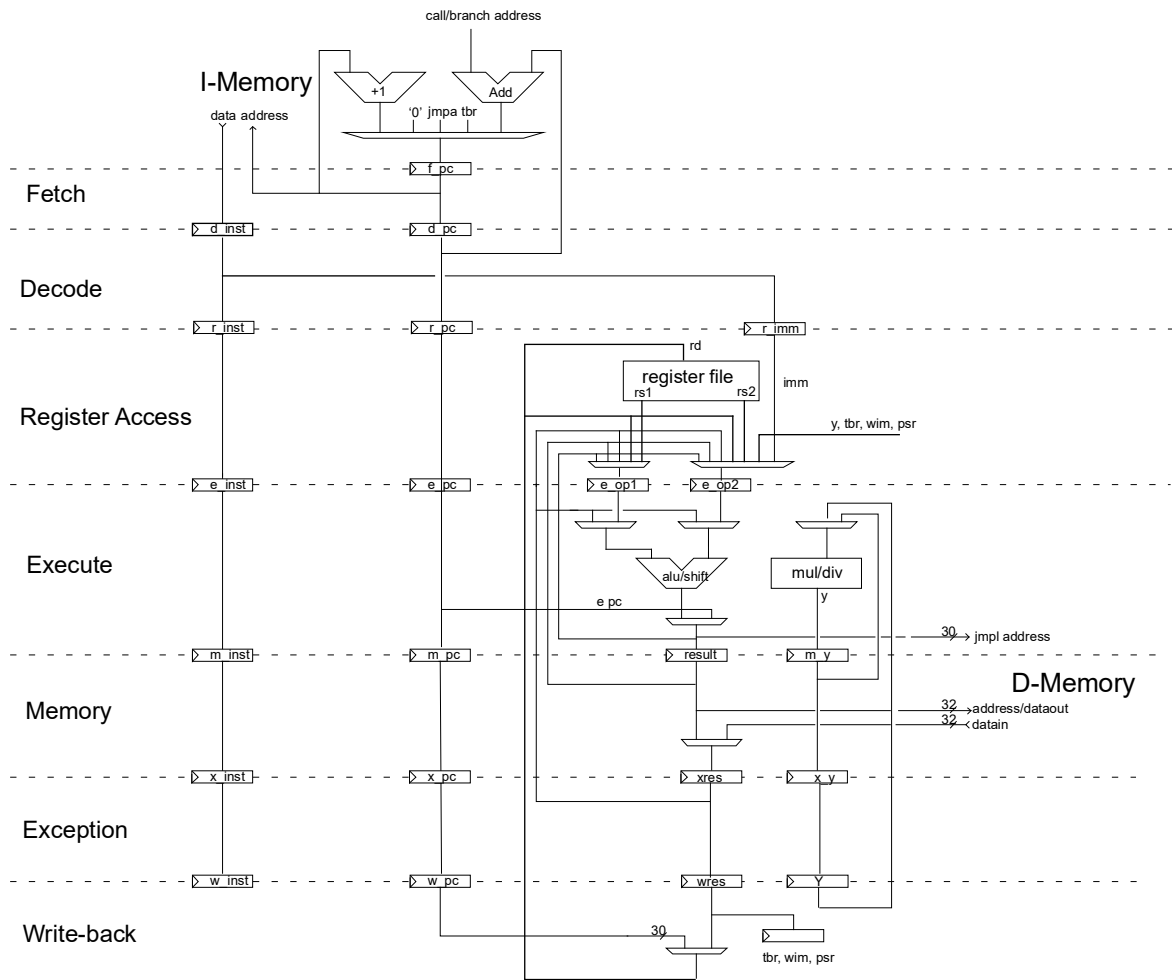


Figure 25. LEON3 integer unit datapath diagram

## 17.2.2 Instruction pipeline

The LEON3 integer unit uses a single instruction issue pipeline with 7 stages:

1. FE (Instruction Fetch): The instruction is fetched from the local instruction memory or external memory located on the AMBA bus. The instruction is valid at the end of this stage and is latched inside the IU.
2. DE (Decode): The instruction is decoded and the CALL and Branch target addresses are generated.
3. RA (Register access): Operands are read from the register file or from internal data bypasses.
4. EX (Execute): ALU, logical, and shift operations are performed. For memory operations (e.g., LD) and for JMPL/RETT, the address is generated.
5. ME (Memory): Data memory is read or written at this time.
6. XC (Exception) Traps and interrupts are resolved. For internal memory reads, the data is aligned as appropriate.
7. WR (Write): The result of any ALU, logical, shift, or internal memory operations are written back to the register file.

# LEON3FT Microcontroller

Table 125 lists the cycles per instruction (assuming local instruction and data memory are used):

Table 125. Instruction timing

Instruction	Cycles
JMPL	3 <sup>1</sup>
JMPL,RETT pair	4
Double load	2
Single store	2
Double store	3
SMUL/UMUL	4
SDIV/UDIV	35
Taken Trap	5
Atomic load/store	3
<b>All other instructions</b>	<b>1</b>

<sup>1</sup> Assuming instruction in JMPL delay slot takes one cycle. Additional cycles spent in the delay slot will reduce the effective time of the JMPL to 2 or 1.

A number of conditions can extend an instruction's duration in the pipeline:

**Branch interlock:** When a conditional branch or trap is performed 1-2 cycles after an instruction which modifies the condition codes, 1-2 cycles of delay is added to allow the condition to be computed. If static branch prediction is enabled, this extra delay is incurred only if the branch is not taken.

**Load delay:** When using data resulting on a load shortly after the load, the instruction will be delayed to satisfy the pipeline's load delay. The processor pipeline is configured for two cycles of load delay.

**Hold cycles:** When blocking on the store buffer, the pipeline will be held still until the data is ready, effectively extending the execution time of the instruction causing the miss by the corresponding number of cycles. Note that since the whole pipeline is held still, hold cycles will not mask load delay or interlock delays.

**FPU/Coprocessor:** The floating-point unit or coprocessor may need to hold the pipeline or extend a specific instruction. When this is done is specific to the FP/CP unit.

## 17.2.3 SPARC Implementor's ID

Frontgrade Gaisler is assigned number 15 (0xF) as SPARC implementor's identification. This value is hard-coded into bits 31:28 in the %psr register. The version number for LEON3 is 3, which is hard-coded in to bits 27:24 of the %psr.

## 17.2.4 Divide instructions

Full support for SPARC V8 divide instructions is provided (SDIV, UDIV, SDIVCC & UDIVCC). The divide instructions perform a 64-by-32 bit divide and produce a 32-bit result. Rounding and overflow detection is performed as defined in the SPARC V8 manual.

## 17.2.5 Multiply instructions

The LEON processor supports the SPARC integer multiply instructions UMUL, SMUL UMULCC and SMULCC. These instructions perform a 32x32-bit integer multiply, producing a 64-bit result. SMUL and SMULCC performs signed multiply while UMUL and UMULCC performs unsigned multiply. UMULCC and SMULCC also set the condition codes to reflect the result. The multiply instructions are performed using a 16x16 hardware multiplier which is iterated four times.

# LEON3FT Microcontroller

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## 17.2.6 Compare and Swap instruction (CASA)

LEON3 implements the SPARC V9 Compare and Swap Alternative (CASA) instruction. The CASA operates as described in the SPARC V9 manual. The instruction is privileged but setting ASI = 0xA (user data) will allow it to be used in user mode.

## 17.2.7 Hardware breakpoints

The integer unit is configured to include 4 hardware breakpoints. Each breakpoint consists of a pair of ancillary state registers (see section 17.6.5). Any binary aligned address range can be watched for instruction or data access, and on a breakpoint hit, trap 0x0B is generated.

## 17.2.8 Instruction trace buffer

The instruction trace buffer consists of a circular buffer that stores executed instructions. This is enabled and accessed only through the processor's debug port via the Debug Support Unit. When enabled, the following information is stored in real time, without affecting performance:

- Instruction address and opcode
- Instruction result
- Load/store data and address
- Trap information
- 30-bit time tag

## 17.2.9 Processor configuration register

The ancillary state register 17 (%asr17) provides information on how various configuration options. This can be used to enhance the performance of software. See section 17.6.2 for layout.

# LEON3FT Microcontroller

## 17.2.10 Exceptions

LEON3 adheres to the general SPARC trap model. The table below shows the implemented traps and their individual priority. When PSR (processor status register) bit ET=0, an exception trap causes the processor to halt execution and enter error mode, and the external error signal will then be asserted.

Table 126. Trap allocation and priority

Trap	TT	Pri	Description	Class
reset	0x00	1	Power-on reset	Interrupting
data_store_error	0x2b	2	write buffer error during data store	Interrupting
instruction_access_exception	0x01	3	Error or MMU page fault during instruction fetch	Precise
privileged_instruction	0x03	4	Execution of privileged instruction in user mode	Precise
illegal_instruction	0x02	5	UNIMP or other un-implemented instruction	Precise
fp_disabled	0x04	6	FP instruction while FPU disabled	Precise
cp_disabled	0x24	6	CP instruction while Co-processor disabled	Precise
watchpoint_detected	0x0B	7	Hardware breakpoint match	Precise
window_overflow	0x05	8	SAVE into invalid window	Precise
window_underflow	0x06	8	RESTORE into invalid window	Precise
r_register_access_error	0x20	9	register file EDAC error (LEON3FT only)	Interrupting
mem_address_not_aligned	0x07	10	Memory access to un-aligned address	Precise
fp_exception	0x08	11	FPU exception	Deferred
cp_exception	0x28	11	Co-processor exception	Deferred
data_access_exception	0x09	13	Access error during data load, MMU page fault	Precise
tag_overflow	0x0A	14	Tagged arithmetic overflow	Precise
division_by_zero	0x2A	15	Divide by zero	Precise
trap_instruction	0x80 - 0xFF	16	Software trap instruction (TA)	Precise
interrupt_level_15	0x1F	17	Asynchronous interrupt 15	Interrupting
interrupt_level_14	0x1E	18	Asynchronous interrupt 14	Interrupting
interrupt_level_13	0x1D	19	Asynchronous interrupt 13	Interrupting
interrupt_level_12	0x1C	20	Asynchronous interrupt 12	Interrupting
interrupt_level_11	0x1B	21	Asynchronous interrupt 11	Interrupting
interrupt_level_10	0x1A	22	Asynchronous interrupt 10	Interrupting
interrupt_level_9	0x19	23	Asynchronous interrupt 9	Interrupting
interrupt_level_8	0x18	24	Asynchronous interrupt 8	Interrupting
interrupt_level_7	0x17	25	Asynchronous interrupt 7	Interrupting
interrupt_level_6	0x16	26	Asynchronous interrupt 6	Interrupting
interrupt_level_5	0x15	27	Asynchronous interrupt 5	Interrupting
interrupt_level_4	0x14	28	Asynchronous interrupt 4	Interrupting
interrupt_level_3	0x13	29	Asynchronous interrupt 3	Interrupting
interrupt_level_2	0x12	30	Asynchronous interrupt 2	Interrupting
interrupt_level_1	0x11	31	Asynchronous interrupt 1	Interrupting

The prioritization follows the SPARC V8 manual except for a minor difference for `r_register_access_error`, which has lower priority than `window_over/underflow` because the window condition is detected before the register file is accessed.

The `data_store_error` is delivered as a deferred exception but is non-resumable and therefore classed as interrupting. Likewise, `r_register_access_error` is delivered as a precise trap but since it is non-resumable it is classed as an interrupting trap.

### 17.2.11 Single vector trapping (SVT)

Single-vector trapping (SVT) is an SPARC V8e option to reduce code size for embedded applications. When enabled, any taken trap will always jump to the reset trap handler (`%tbr.tba + 0`). The trap type will be indicated in `%tbr.tt`, and must be decoded by the shared trap handler. SVT is enabled by setting bit 13 in `%asr17`.

### 17.2.12 Address space identifiers (ASI)

In addition to the address, a SPARC processor also generates an 8-bit address space identifier (ASI), providing up to 256 separate, 32-bit address spaces. During normal operation, the LEON3 processor accesses instructions and data using ASI `0x8 - 0xB` as defined in the SPARC manual. Using the LDA/STA instructions, alternative address spaces can be accessed. The different available ASIs are described in section 17.6.

### 17.2.13 Partial WRPSR

The processor has support for partial WRPSR. Partial write %PSR (WRPSR) is a SPARC V8e option that allows WRPSR instructions to only affect the %PSR.ET field.

### 17.2.14 Alternative window pointer

Alternative window pointer (AWP) is a SPARC V8e option intended to reduce interrupt latency by allowing code that manipulates the current window pointer, mainly window over and underflow handlers and context switching code, to run with traps enabled.

Two bits are added to the PSR register, AW (alternative window) and PAW (previous alternative window). Also an AWP (alternative window pointer) field is added in an ASR register.

When the AW bit is set, the current register window used for reading/writing non-global registers is taken from the AWP register field instead of the normal CWP register field, and SAVE and RESTORE operations modify the AWP field instead of the CWP. SAVE and RESTORE can do not trigger the window over/underflow traps while AW is set.

When both AW and PAW are zero, the AWP field is kept equal to the CWP field.

When a trap occurs, the value of AW is copied into the PAW field, and AW is cleared. When returning from a trap using the RETT instruction, the PAW field is copied back into AW. The RETT will not trigger the window underflow trap if PAW is set regardless of if CWP or AWP point to an invalid window.

### 17.2.15 Register file partitioning

Register file partitioning is an optional extension to allow a subrange of the register windows to be used as if it was the whole register file. The selected subset is connected in a ring so that the outs of the lowest register window is aliased to the ins of the highest register window in the range. Other register windows outside this range are not accessible and will be kept at their old values while the partitioning is enabled.

The partitioning is activated by setting the STWIN and CWPMAX fields of the %asr20 register. This selects the subset of windows between STWIN and STWIN+CWPMAX so that they map to CWP values 0 to CWPMAX. STWIN and CWPMAX must be set so they map to a valid range, CWPMAX+STWIN must not exceed the highest possible CWP value supported in the normal case. Also, for correct operation, CWP must be set to a value between 0 and CWPMAX before accessing any non-global register.

Writing CWPMAX to (otherwise illegal value) 0 in %asr20 will result in writing only AWP and keeping the values of STWIN and CWPMAX.



# LEON3FT Microcontroller

A special write-only bit in the %asr20 register can be used to write CWP in the PSR at the same time as writing the STWIN,CWPMAX,AWP fields, this is intended to allow switching between two register file partitions without disabling interrupts.

The WIM register is not managed by the partitioning logic, therefore the lowest bits of the WIM will map to the partitioned windows. The highest bits of the WIM will be masked to 0 on read to simulate a smaller register file, however these bits are still writable.

## 17.2.16 Power-down

The processor can enter a power-down mode to minimize power consumption during idle periods. The power-down mode is entered by performing a WRASR instruction to %asr19:

```
wr %g0, %asr19
```

During power-down, the pipeline is halted until the next interrupt occurs. Signals inside the processor pipeline are then static, reducing power consumption from dynamic switching.

Note: %asr19 must always be written with the data value zero to ensure compatibility with future extensions.

Note: This instruction must be performed in supervisor mode with interrupts enabled.

When resuming from power-down, the pipeline will be re-filled from the point of power-down and the first instruction following the WRASR instruction will be executed prior to taking the interrupt trap. Up to six instructions after the WRASR instruction will be fetched prior to fetching the trap handler.

## 17.2.17 Processor reset operation

The processor is reset by asserting the RESET input for at least 4 clock cycles. The following table indicates the reset values of a subset of the registers which are affected by the reset..

Table 127.Processor reset values

Register	Reset value
Trap Base Register	Trap Base Address field reset (value 0)
PC (program counter)	0x0
nPC (next program counter)	0x4
PSR (processor status register)	ET=0, S=1

By default, the execution will start from address 0 and is taken from the register processor boot address register in the interrupt controller. This allows processor to be dynamically restarted and the reset address to be changed dynamically and can e.g. when new software has been remotely uploaded and processor should restart.

## 17.2.18 LEON-REX extension

The processor supports the LEON-REX addition to the SPARC instruction set, allowing a more compact code representation than the regular SPARC machine code, see reference document [LEON-REX].

Detection whether support is present can be done by checking the REXV field in the asr17 register (see section 17.6.2). The REX support can be set to enabled, illegal or transparent mode via the REXEN/REXILL bits in the asr17 register. Enabled: REXEN=0, REXILL=0. Illegal: REXEN=0, REXILL=1. Transparent: REXEN=1, REXILL=0. After reset the default setting is illegal (TBC, REXEN=1, REXILL=1) so any LEON-REX code will cause an illegal instruction trap.

### 17.2.19 Constant interrupt delay

The LEON3FT is enhanced with an interrupt zero jitter feature. When the interrupt zero jitter feature is enabled all sources of interrupt jitter introduced by the hardware can be eliminated. The latency is controlled via a 12 bit counter register which also determines the interrupt latency. If the 12 bit counter is set in the range 0 to 4, the LEON3FT will start to process the interrupt request as soon as possible. If the counter is set to a specific value depending on the timing of the memory system, then it can enable the zero jitter behavior to force the interrupt latency to higher number of cycles, but it is guaranteed to have zero jitter.

The processor interrupt delay bit fields are found and in the ASI2 register. Example of setting the interrupt delay to 10 clock cycles:

```
asm volatile (" sta %0, [%1] 2" : : "r"(10), "r"(4) : "memory");
```

# LEON3FT Microcontroller

## 17.3 Local instruction and data RAM

Local instruction and data ram is attached to the processor. The local instruction ram is 64 KiB and the local data ram is 64 KiB. Accesses performed to the local RAMs will not appear on the AHB bus. The address for the instruction ram is 0x31000000, and for the data ram 0x30000000.

The local instruction RAM is intended for executing instructions and will serve instructions without any wait states. Initializing the local instruction RAM is done from software via stores or remotely via the local instruction memory AHB interface on the DMA bus.

The local data RAM will serve data accesses of any size without adding wait states. The local data RAM can be accessed via AHB from any AMBA master with access to the DMA bus.

## 17.4 GRFPU-Lite floating-point unit

Frontgrade Gaisler’s GRFPU-Lite is connected with the LEON3 pipeline. The GRFPU-Lite is a smaller version of the GRFPU, suitable for implementations with limited logic resources. The GRFPU-Lite is not pipelined and thus executes only one instruction at a time. To improve performance, the FPU controller (GRLFPC) allows GRFPU-Lite to execute in parallel with the processor pipeline as long as no new FPU instructions are pending. Below is a table of worst-case throughput of the GRFPU-Lite:

Table 128. GRFPU-Lite worst-case instruction timing with GRLFPC

Instruction	Throughput	Latency
FADDS, FADDD, FSUBS, FSUBD, FMULS, FMULD, FSMULD, FITOS, FITOD, FSTOI, FDTOI, FSTOD, FDTOS, FCMPs, FCMPD, FCMPEs, FCMPEd	8	8
FDIVS	31	31
FDIVD	57	57
FSQRTS	46	46
FSQRTD	65	65

The GRLFPC controller implements the SPARC deferred trap model, but the FPU trap queue (FQ) can contain only one queued instructions when an FPU exception is taken. When the GRFPU-Lite is enabled in the model, the version field in %fsr has the value of 3.

# LEON3FT Microcontroller

## 17.5 AMBA interface

### 17.5.1 Overview

The LEON3 processor uses one AHB master interface for all data and instruction accesses. Instructions and data are fetched with single READ cycles. Store data is performed using single accesses or a two-beat incremental burst in case of 64-bit store.

The HPROT signals of the AHB bus are driven to indicate if the accesses is instruction or data, and if it is a user or supervisor access.

Table 129.HPROT values

Type of access	User/Super	HPROT
Instruction	User	1100
Instruction	Super	1110
Data	User	1101
Data	Super	1111

In case of atomic accesses, a locked access will be made on the AMBA bus to guarantee atomicity as seen from other masters on the bus.

### 17.5.2 Error handling

An AHB ERROR response received while fetching instructions will normally cause an instruction access exception (tt=0x1).

An AHB ERROR response while fetching data will normally trigger a data\_access\_exception trap (tt=0x9).

# LEON3FT Microcontroller

## 17.6 Configuration registers

### 17.6.1 PSR, WIM, TBR registers

The %psr, %wim, %tbr registers are implemented as required by the SPARC V8 manual.

Table 130. LEON3 Processor state register (%psr)

31				28				27				24				23				20				19				16															
IMPL								VER								ICC								RESERVED																			
0xF								0x3								0								0																			
r								r								r								r																			
15				14				13				12				11				8				7				6				5				4				0			
RESERVED				EC				EF				PIL				S				PS				ET				CWP															
0				0				0				0				1				1				0				0															
r				r				rw				rw				rw				rw				rw																			

- 31:28 Implementation ID (IMPL), read-only hardwired to “1111” (15)
- 27:24 Implementation version (VER), read-only hardwired to “0011” (3) for LEON3.
- 23:20 Integer condition codes (ICC), see sparcv8 for details
- 19:14 Reserved
- 13 Enable coprocessor (EC), always set to '0' to indicate no coprocessor available in microcontroller
- 12 Enable floating-point (EF)
- 11:8 Processor interrupt level (PIL) - controls the lowest IRQ number that can generate a trap
- 7 Supervisor (S)
- 6 Previous supervisor (PS), see sparcv8 for details
- 5 Enable traps (ET)
- 4:0 Current window pointer

Table 131. LEON3 Window invalid mask (%wim)

31																30																0															
R																WIM																															
0																NR																															
r																rw																															

Table 132. LEON3 Trap base address register (%tbr)

31												12												11												4												3												0											
TBA												TT												R																																															
*												0												0																																															
rw												r												r																																															

- 31:12 Trap base address (TBA) - Top 20 bits used for trap table address
- 11:4 Trap type (TT) - Last taken trap type. Read only.
- 3:0 Always zero, read only

# LEON3FT Microcontroller

## 17.6.2 ASR17, LEON3 configuration register

The ancillary state register 17 (%asr17) provides information on current LEON3FT configuration. This can be used to enhance the performance of software. There are also a few bits that are writable to configure certain aspects of the processor.

Table 133. LEON3 configuration register (%asr17)

31				28	27	26	25	24	23	22	21	20		18	17	16
INDEX				R	NOTAG	R	REXV	REXEN	REXILL	RESERVED				R	R	
0				0	1	1	01b	1	1	0				0	0	
r				r	r	r	r	rw	rw	r				r	r	
15	14	13	12	11	10	9	8	7		5	4	0				
R	DW	SV	LD	FPU		M	V8	NWP			NWIN					
0	0	0	1	3		0	1	4			30					
r	rw	rw	r	r		r	r	r			r					

- 31:28 Processor index (INDEX) -Processor index is set to zero.
- 27 Reserved and not used
- 26 Tagged arithmetic (NOTAG) - Then the processor supports tagged arithmetic.and compare-and-swap (CASA) instruction.
- 27 Reserved and not used
- 24:23 REX version (REXV) - REX version
- 22 REX enable (REXEN) - Set to 0 to enable REX, 1 to disable. Writable. Reset value 1.
- 21 REX illegal (REXILL) - Set to 0 to enable REX, 1 to generate illegal instruction exceptions. Writable. Reset value 1. See section 17.2.18 for how this bit together with REXEN sets the REX mode.
- 20:18 Reserved for future implementations
- 17 Reserved for future implementations
- 16:15 Reserved for future implementations
- 14 Disable write error trap (DWT). When set, a write error trap (tt = 0x2b) will be ignored. Set to zero after reset.
- 13 Single-vector trapping (SVT) enable. If set, will enable single-vector trapping. Set to zero after reset.
- 12 Load delay (LDDEL) - Indicates 2-cycle load delay is used.
- 11:10 FPU Option (FPU) - Indicates system has a GRFPU-Lite
- 9 MAC instruction (M) - Set to zero to indicate multiply-accumulate (MAC) instruction is NOT available
- 8 MUL/DIV instructions available (V8) - Indicates SPARC V8 multiply and divide instructions are available
- 7:5 Hardward watchpoints (NWP) - Number of watchpoints available is 4
- 4:0 Register windows (NWIN) - Number of implemented registers windows corresponds to NWIN+1 i.e. 31 for GR716.

# LEON3FT Microcontroller

## 17.6.3 ASR20, Alternative window register

This register allows access to the alternative window pointer.

Table 134. LEON3 alternative window register (%asr20)

31	RESERVED	26	25	21	20	16
	0		STWIN	0		CWPMAX
	r		rw	rw		rw
15	RESERVED			5	4	0
	0		WCWP	-		AWP
	r		w	rw		rw

- 31:26      Reserved for future implementations
- 25:21      Starting window (STWIN) - Starting window of partition.
- 20:16      Maximum value of current window pointer (CWPMAX) - Partition size minus 1. Reset value is number of windows minus 1, which with STWIN=0 maps whole register file into partition. If this field is written with value 0, STWIN and CWPMAX fields are unmodified.
- 15:5        Reserved for future implementations
- 5            Write CWP - If written with 1, then the CWP field in PSR will simultaneously be written with the value written to AWP.
- 4:0         Alternative Window Pointer (AWP). Continuously updated with the value of CWP when the alternative window feature is disabled.

# LEON3FT Microcontroller

## 17.6.4 ASR22-23 - Up-counter

The ancillary state registers 22 and 23 (%asr22-23) contain an internal up-counter that can be read by software without causing any access on the on-chip AMBA bus. The number of available bits in the counter is 32 bits and is the same as the number of counter bits in the DSU time tag counter. %ASR23 contains the least significant part of the counter value and %ASR22 contains the most significant part.

The time tag value accessible in these registers is the same time tag value used for the system's trace buffers and for all processors connected to the same debug support unit. The time tag counter will increment when any of the trace buffers is enabled, or when the time tag counter is forced to be enabled via the DSU register interface, or when any processor has its %ASR22 Disable Up-counter (DUCNT) field set to zero.

The up-counter value will increment even if all processors have entered power-down mode.

Table 135. LEON3 up-counter MSBs (%ASR22)

31	30	0
DUCNT	Not Used	
31	Disable Up-counter (DUCNT) - Disable upcounter. When set to '1' the up-counter may be disabled. When cleared, the counter will increment each processor clock cycle. Default (reset) value is '1'.	
30:0	Reserved and not used	

Table 136. LEON3 up-counter LSbs (%ASR23)

31	0
UPCNT(31:0)	
31:0	Counter value (UPCNT(31:0)) - Least significant bits of internal up-counter. Read-only.



# LEON3FT Microcontroller

## 17.6.5 ASR24-31, Hardware watchpoint/breakpoint registers

Each breakpoint consists of a pair of ancillary state registers (%asr24/25, %asr26/27, %asr28/29 and %asr30/31) registers; one with the break address and one with a mask:

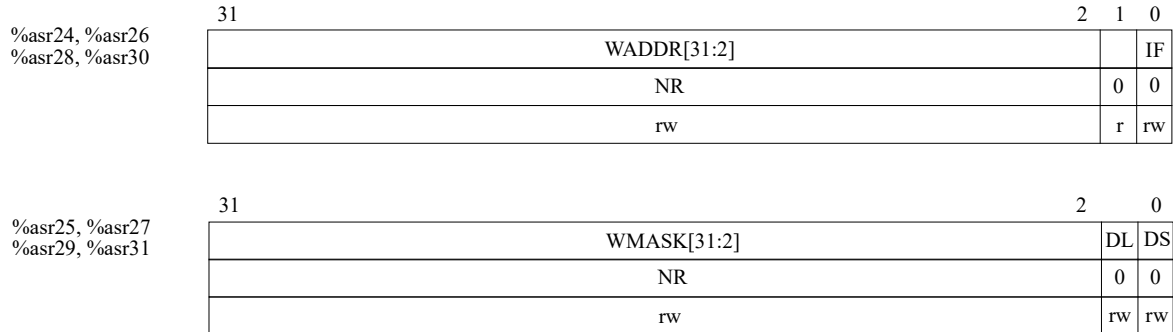


Figure 26. Watch-point registers

WADDR - Address to compare against

WMASK - Bit mask controlling which bits to check (1) or ignore (0) for match

IF - break on instruction fetch from the specified address/mask combination

DL - break on data load from the specified address/mask combination

DS - break on data store to the specified address/mask combination

Note: Setting IF=DL=DS=0 disables the breakpoint

When there is a hardware watchpoint match and DL or DS is set then trap 0x0B will be generated. Hardware watchpoints can be used with or without the LEON3 debug support unit (DSU) enabled.

# LEON3FT Microcontroller

## 17.6.6 Register protection control register

ASR register 16 (%asr16) is used to control the IU/FPU register file SEU protection. It is possible to disable the SEU protection by setting the IDI/FDI bits, and to inject errors using the ITE/FTE bits. Corrected errors in the register file are counted, and available in ICNT and FCNT fields. The counters saturate at their maximum value (7), and should be reset by software after read-out.

Table 137. LEON3FT Register protection control register (%asr16)

31	30	29	27	26	20	19	18	17	16
RESERVED		FCNT		RESERVED			EIUFT	FTE	FDI
0		0		0			1	0	0
r		rw		r			r	rw	r
15	14	13	11	10	3	2	1	0	
IUFT		ICNT		RFTB[7:0]			DP	ITE	IDI
1		0		0			0	0	0
r		rw		rw			rw	rw	rw

- 31:30      Reserved for future implementations
- 29:27      FP RF error counter - Number of detected parity errors in the FP register file.
- 26: 20      Reserved for future implementations
- 19: 18      Extended IU FT ID - Top bits of IUFT field to indicate FT values higher than 3
- 17          FPU RF Test Enable - Enables FPU register file test mode. Parity bits are xored with TB before written to the FPU register file.
- 16          FP RF protection disable (FDI) - Disables FP RF parity protection when set.
- 15:14      IU FT ID - SEU protection is available for IU
- 13:11      IU RF error counter - Number of detected parity errors in the IU register file.
- 10:3       RF Test bits (RFTB) - In test mode, these bits are xored with correct parity bits before written to the register file.
- 2           DP ram select (DP) - Only applicable if the IU or FPU register files consists of two dual-port rams. See table 138 below.
- 1           IU RF Test Enable - Enables register file test mode. Parity bits are xored with TB before written to the register file.
- 0           IU RF protection disable (IDI) - Disables IU RF parity protection when set.

Table 138. DP ram select usage

ITE/FTE	DP	Function
1	0	Write to IU register (%i, %l, %o, %g) will only write location of %rs2 Write to FPU register (%f) will only write location of %rs2
1	1	Write to IU register (%i, %l, %o, %g) will only write location of %rs1 Write to FPU register (%f) will only write location of %rs1
0	X	IU and FPU registers written nominally

## 17.7 Software considerations

### 17.7.1 Register file initialization on power up for LEON3FT

This section is only valid if internal boot ROM is bypassed.

After power-on and internal boot ROM is bypassed, the check bits in the IU and FPU register files are not initialized. This means that access to an un-initialized (un-written) general-purpose register could cause a register access trap (tt = 0x20). Such behavior is considered as a software error, as the software should not read a register before it has been written. It is recommended that the boot code for the processor writes all registers in the IU and FPU register files before launching the main application. Initialization of IU and FPU register files is performed by the internal boot ROM before handover to application software.

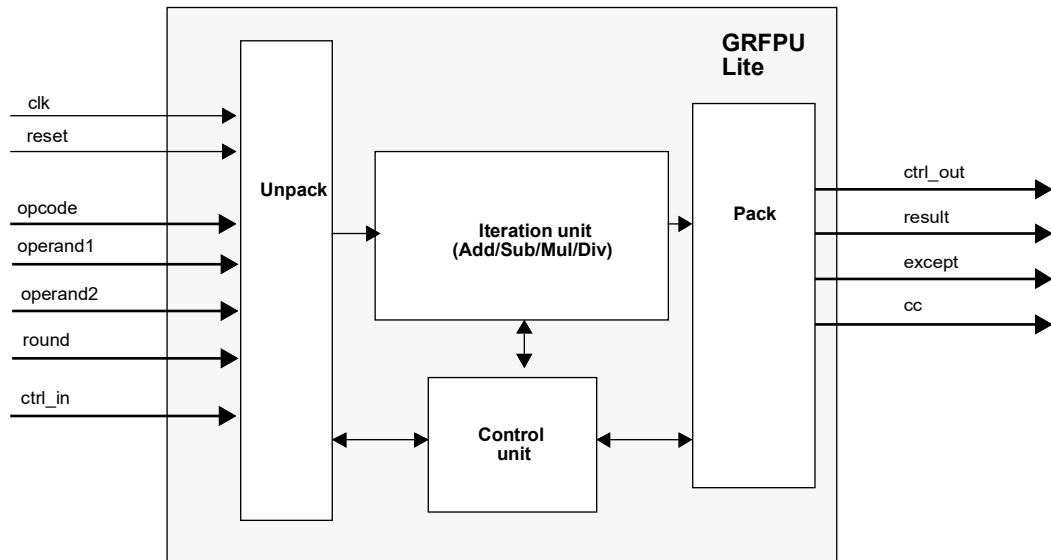
# LEON3FT Microcontroller

## 18 IEEE-754 Floating-Point Unit

### 18.1 Overview

The floating-point unit implements floating-point operations as defined in IEEE Standard for Binary Floating-Point Arithmetic (IEEE-754) and SPARC V8 standard (IEEE-1754).

Supported formats are single and double precision floating-point numbers. The floating-point unit is not pipelined and executes one floating-point operation at a time.



### 18.2 Functional Description

#### 18.2.1 Floating-point number formats

The floating-point unit handles floating-point numbers in single or double precision format as defined in IEEE-754 standard.

# LEON3FT Microcontroller

## 18.2.2 FP operations

The floating-point unit supports four types of floating-point operations: arithmetic, compare, convert and move. The operations, summarized in the table below, implement all FP instructions specified by the SPARC V8 instruction set except FSMULD and instructions with quadruple precision.

Table 139.: Floating-point operations

Operation	Op1	Op2	Result	Exceptions	Description
Arithmetic operations					
FADDS FADDD	SP DP	SP DP	SP DP	NV, OF, UF, NX	Addition
FSUBS FSUBD	SP DP	SP DP	SP DP	NV, OF, UF, NX	Subtraction
FMULS FMULD	SP DP	SP DP	SP DP	NV, OF, UF, NX NV, OF, UF, NX	Multiplication
FDIVS FDIVD	SP DP	SP DP	SP DP	NV, OF, UF, NX, DZ	Division
FSQRTS FSQRTD	- -	SP DP	SP DP	NV, NX	Square-root
Conversion operations					
FITOS FITOD	-	INT	SP DP	NX -	Integer to floating-point conversion
FSTOI FDTOI	-	SP DP	INT	NV, NX	Floating-point to integer conversion. The result is rounded in round-to-zero mode.
FSTOD FDTOS	-	SP DP	DP SP	NV NV, OF, UF, NX	Conversion between floating-point formats
Comparison operations					
FCMPS FCMPD	SP DP	SP DP	CC	NV	Floating-point compare. Invalid exception is generated if either operand is a signaling NaN.
FCMPES FCMPED	SP DP	SP DP	CC	NV	Floating point compare. Invalid exception is generated if either operand is a NaN (quiet or signaling).
Negate, Absolute value and Move					
FABSS	-	SP	SP	-	Absolute value.
FNEGS	-	SP	SP	-	Negate.
FMOVS		SP	SP	-	Move. Copies operand to result output.

SP - single precision floating-point number

DP - double precision floating-point number

INT - 32 bit integer

CC - condition codes

NV, OF, UF, NX - floating-point exceptions, see section 18.2.3

Below is a table of worst-case throughput of the floating point unit.

Table 140. Worst-case instruction timing

Instruction	Throughput	Latency
FADDS, FADDD, FSUBS, FSUBD, FMULS, FMULD, FITOS, FITOD, FSTOI, FDTOI, FSTOD, FDTOS, FCMPS, FCMPD, FCMPE, FCMPED	8	8
FDIVS	31	31
FDIVD	57	57
FSQRTS	46	46
FSQRTD	65	65

### 18.2.3 Exceptions

The floating-point unit detects all exceptions defined by the IEEE-754 standard. This includes detection of Invalid Operation (NV), Overflow (OF), Underflow (UF), Division-by-Zero (DZ) and Inexact (NX) exception conditions. Generation of special results such as NaNs and infinity is also supported.

### 18.2.4 Rounding

All four rounding modes defined in the IEEE-754 standard are supported: round-to-nearest, round-to-+inf, round-to--inf and round-to-zero.

# LEON3FT Microcontroller

## 19 UART Serial Interface

The GR716 comprises 6 separate UART units and 2 debug and remote access UART units. The 2 debug and remote access UART units also called AHBUART units are described in section 48. This chapter only describes the UART units also called APBUART. The main difference between the UART units described in this section and the debug UART units are the debug and remote access UART units capability to respond to external UART signaling without software support. The two debug and remote access UART units can also act as a master on the internal bus without software support. The UART units described in this section requires software support for all operations.

The APB UART units are located on APB bus in the address range from 0x80300000 to 0x80305FFF. See UART units connections in the next drawing. The figure shows memory locations and functions used for UART configuration and control.

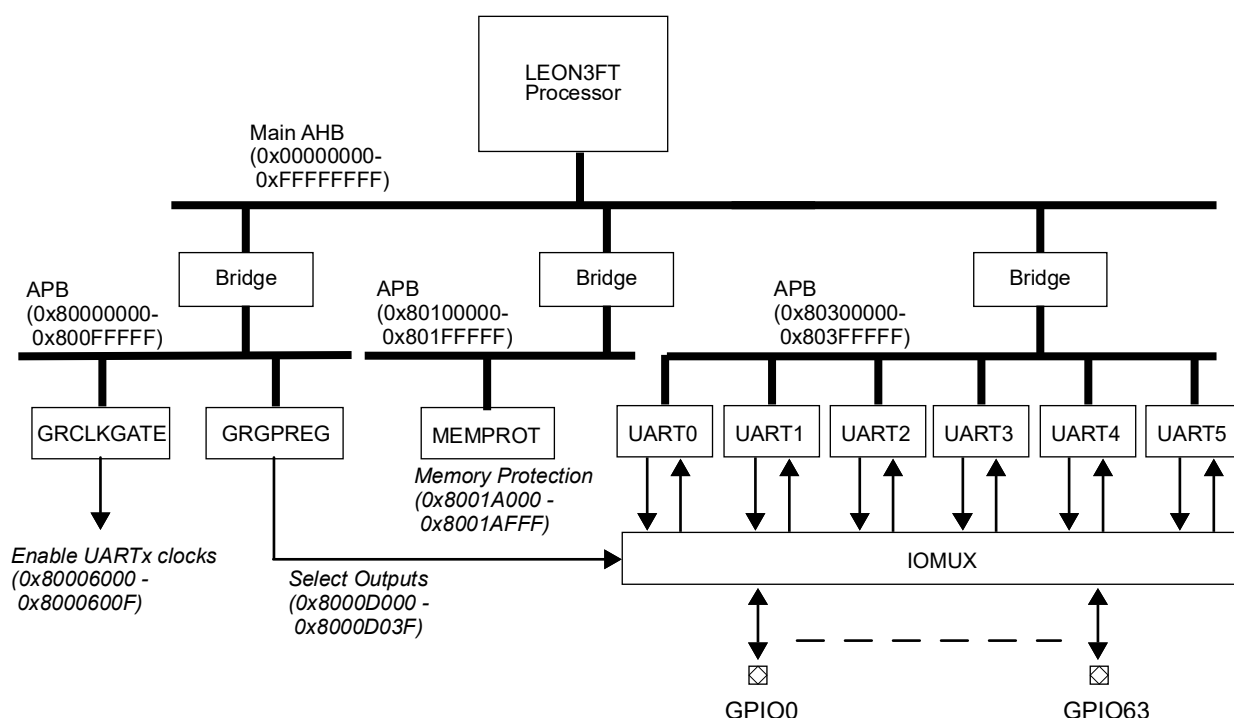


Figure 27. GR716 UART bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable individual UART units. The unit **GRCLKGATE** can also be used to perform reset of individual UART units. Software must enable clock and release reset described in section 27 before UART configuration and transmission can start.

External IO selection per UART unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

Each **UARTx** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. UART unit 0, 1, 2, 3, 4 and 5 have identical configuration and status registers. Configuration and status registers are described in section 19.7.

The system can be configured to protect and restrict access to individual UART unit in the **MEMPROT** unit. See section 47 for more information.

# LEON3FT Microcontroller

## 19.1 Overview

The universal asynchronous receiver-transmitter (UART) interface takes bytes and transmits the individual bit sequentially. The UART supports data frames with 8 data bits, one optional parity bit and one or two stop bits. To generate the bit-rate, each UART has a programmable 12-bit clock divider. To minimize the interrupts two 16-byte FIFOs are used for data transfer between the APB bus and UART, one FIFO for reception and one for transmission. Hardware flow-control is supported through the RTSN/CTS signal. Parity checking can be enabled per UART interface.

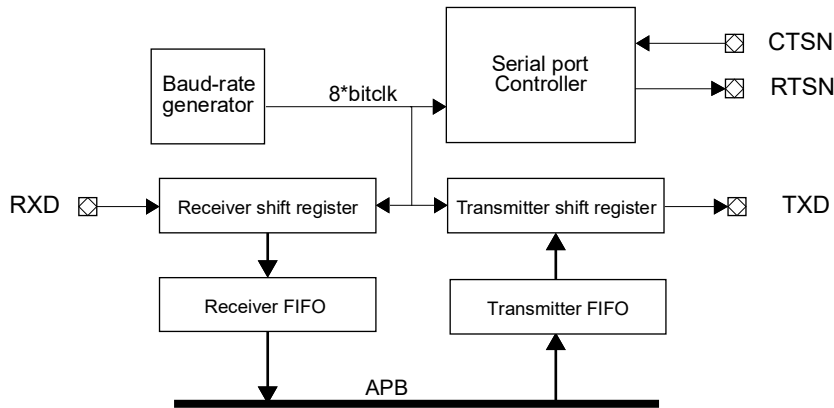


Figure 28. UART unit block diagram

## 19.2 Operation

### 19.2.1 Transmitter operation

The transmitter is enabled through the TE bit in the UART control register. Data that is to be transferred is stored in the 16-byte FIFO by writing to the data register. When ready to transmit, data is transferred from the transmitter FIFO to the transmitter shift register and converted to a serial stream on the transmitter serial output pin (TXD). It automatically sends a start bit followed by eight data bits, an optional parity bit, and one stop bit (figure 29). The least significant bit of the data is sent first. It is also possible to use two stop bits, this is configured via the control register.

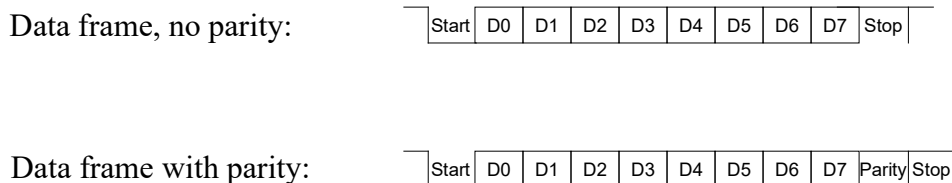


Figure 29. UART data frames

Following the transmission of the stop bit, if a new character is not available in the transmitter FIFO, the transmitter serial data output remains high and the transmitter shift register empty bit (TS) will be set in the UART status register. Transmission resumes and the TS is cleared when a new character is



# LEON3FT Microcontroller

loaded into the transmitter FIFO. When the FIFO is empty the TE bit is set in the status register. If the transmitter is disabled, it will immediately stop any active transmissions including the character currently being shifted out from the transmitter shift register. The transmitter FIFO may not be loaded when the transmitter is disabled or when the FIFO is full. If this is done, data might be overwritten and one or more frames are lost.

The TF status bit (not to be confused with the TF control bit) is set if the transmitter FIFO is currently full and the TH bit is set as long as the FIFO is *less* than half-full (less than half of entries in the FIFO contain data). The TF control bit enables FIFO interrupts when set. The status register also contains a counter (TCNT) showing the current number of data entries in the FIFO.

When flow control is enabled, the CTSN input must be low in order for the character to be transmitted. If it is deasserted in the middle of a transmission, the character in the shift register is transmitted and the transmitter serial output then remains inactive until CTSN is asserted again. If the CTSN is connected to a receiver's RTSN, overrun can effectively be prevented.

## 19.2.2 Receiver operation

The receiver is enabled for data reception through the receiver enable (RE) bit in the UART control register. The receiver looks for a high to low transition of a start bit on the receiver serial data input pin. If a transition is detected, the state of the serial input is sampled a half bit clocks later. If the serial input is sampled high the start bit is invalid and the search for a valid start bit continues. If the serial input is still low, a valid start bit is assumed and the receiver continues to sample the serial input at one bit time intervals (at the theoretical centre of the bit) until the proper number of data bits and the parity bit have been assembled and one stop bit has been detected.

The receiver also has a 16-byte FIFO which is identical to the one in the transmitter.

During reception, the least significant bit is received first. The data is then transferred to the receiver FIFO and the data ready (DR) bit is set in the UART status register as soon as the FIFO contains at least one data frame. The parity, framing and overrun error bits are set at the received byte boundary, at the same time as the receiver ready bit is set. The data frame is not stored in the FIFO if an error is detected. Also, the new error status bits are *or*'ed with the old values before they are stored into the status register. Thus, they are not cleared until written to with zeros from the AMBA APB bus. If both the receiver FIFO and shift registers are full when a new start bit is detected, then the character held in the receiver shift register will be lost and the overrun bit will be set in the UART status register. A break received (BR) is indicated when a BREAK has been received, which is a framing error with all data received being zero.

RTSN will be negated (high) when a valid start bit is detected and the receiver FIFO is full. When the FIFO is read, the RTSN will automatically be reasserted again. This behavior applies regardless of the value of the FL bit in the UART control register.

The RF status bit (not to be confused with the RF control bit) is set when the receiver FIFO is full. The RH status bit is set when the receiver FIFO is half-full (at least half of the entries in the FIFO contain data frames). The RF control bit enables receiver FIFO interrupts when set. A RCNT field is also available showing the current number of data frames in the FIFO.

## 19.3 Baud-rate generation

Each UART contains a 12-bit down-counting scaler to generate the desired baud-rate. The scaler is clocked by the system clock and generates a UART tick each time it underflows. It is reloaded with the value of the UART scaler reload register after each underflow. The resulting UART tick frequency should be 8 times the desired baud-rate. One appropriate formula to calculate the scaler value for a desired baud rate, using integer division where the remainder is discarded, is:

$$\text{scaler value} = (\text{system\_clock\_frequency}) / (\text{baud\_rate} * 8 + 7).$$

To calculate the exact required scaler value use:

# LEON3FT Microcontroller

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$$\text{scaler value} = (\text{system\_clock\_frequency}) / (\text{baud\_rate} * 8) - 1$$

## 19.4 Loop back mode

If the LB bit in the UART control register is set, the UART will be in loop back mode. In this mode, the transmitter output is internally connected to the receiver input and the RTSN is connected to the CTSN. It is then possible to perform loop back tests to verify operation of receiver, transmitter and associated software routines. In this mode, the outputs remain in the inactive state, in order to avoid sending out data.

## 19.5 FIFO debug mode

FIFO debug mode is entered by setting the debug mode bit in the control register. In this mode it is possible to read the transmitter FIFO and write the receiver FIFO through the FIFO debug register. The transmitter output is held inactive when in debug mode. A write to the receiver FIFO generates an interrupt if receiver interrupts are enabled.

## 19.6 Interrupt generation

Two different kinds of interrupts are available: normal interrupts and FIFO interrupts.

Normal interrupts from the transmitter are generated when transmitter interrupts are enabled (TI), the transmitter is enabled and the transmitter FIFO goes from containing data to being empty. For the receiver normal interrupts are generated when receiver interrupts are enabled (RI), the receiver is enabled and a character is received. The interrupt is generated if the character is correct and stored in the receive FIFO or if an error, such as parity, framing or overrun occurred.

Transmitter FIFO interrupts are generated when the transmitter FIFO interrupts are enabled (TF), transmissions are enabled (TE) and the UART is less than half-full (that is, whenever the TH status bit is set). This is a level interrupt and the interrupt signal is continuously driven high as long as the condition prevails. Receiver FIFO interrupts are generated when receiver FIFO interrupts are enabled (RF), the receiver is enabled and the FIFO is half-full. The interrupt signal is continuously driven high as long as the receiver FIFO is half-full (at least half of the entries contain data frames).

Note that the processor acknowledges and clears the corresponding interrupt pending register but for FIFO interrupts the interrupt signal from the UART is continuously driven high, resulting in a new pending interrupt immediately being set in the interrupt controller. If FIFO interrupts are used for controlling FIFO handling, an interrupt handler need to check that there is room in the transmit FIFO before writing and that characters are available in the receive FIFO before reading.

To reduce interrupt occurrence a delayed receiver interrupt is available. It is enabled using the delayed interrupt enable (DI) bit. When enabled a timer is started each time a character is received and an interrupt is only generated if another character has not been received within 4 character + 4 bit times. If receiver FIFO interrupts are enabled a pending character interrupt will be cleared when the FIFO interrupt is active since the character causing the pending irq state is already in the FIFO and is noticed by the driver through the FIFO interrupt. In order to not take one additional interrupt, software should clear the corresponding pending bit after the FIFO has been emptied.

There is also a separate interrupt for break characters. When enabled an interrupt will always be generated immediately when a break character is received even when delayed receiver interrupts are enabled. When break interrupts are disabled no interrupt will be generated for break characters when delayed interrupts are enabled.

When delayed interrupts are disabled the behavior is the same for the break interrupt bit except that an interrupt will be generated for break characters if receiver interrupt enable is set even if break interrupt is disabled.

An interrupt can also be enabled for the transmitter shift register. When enabled the core will generate an interrupt each time the shift register goes from a non-empty to an empty state.

# LEON3FT Microcontroller

## 19.7 Registers

The core is controlled through registers mapped into APB address space.

Table 141. UART registers

APB address offset	Register
0x80300000	UART0 Data register (UART0.DATA)
0x80300004	UART0 Status register (UART0.STATUS)
0x80300008	UART0 Control register (UART0.CTRL)
0x8030000C	UART0 Scaler register (UART0.SCALER)
0x80300010	UART0 FIFO debug register (UART0.FIFO)
0x80301000	UART1 Data register (UART1.DATA)
0x80301004	UART1 Status register (UART1.STATUS)
0x80301008	UART1 Control register (UART1.CTRL)
0x8030100C	UART1 Scaler register (UART1.SCALER)
0x80301010	UART1 FIFO debug register (UART1.FIFO)
0x80302000	UART2 Data register (UART2.DATA)
0x80302004	UART2 Status register (UART2.STATUS)
0x80302008	UART2 Control register (UART2.CTRL)
0x8030200C	UART2 Scaler register (UART2.SCALER)
0x80302010	UART2 FIFO debug register (UART2.FIFO)
0x80303000	UART3 Data register (UART3.DATA)
0x80303004	UART3 Status register (UART3.STATUS)
0x80303008	UART3 Control register (UART3.CTRL)
0x8030300C	UART3 Scaler register (UART3.SCALER)
0x80303010	UART3 FIFO debug register (UART3.FIFO)
0x80304000	UART4 Data register (UART4.DATA)
0x80304004	UART4 Status register (UART4.STATUS)
0x80304008	UART4 Control register (UART4.CTRL)
0x8030400C	UART4 Scaler register (UART4.SCALER)
0x80304010	UART4 FIFO debug register (UART4.FIFO)
0x80305000	UART5 Data register (UART5.DATA)
0x80305004	UART5 Status register (UART5.STATUS)
0x80305008	UART5 Control register (UART5.CTRL)
0x8030500C	UART5 Scaler register (UART5.SCALER)
0x80305010	UART5 FIFO debug register (UART5.FIFO)

# LEON3FT Microcontroller

## 19.7.1 UART Data Register

Table 142. 0x00 - DATA - UART data register

31	8	7	0
RESERVED		DATA	
		NR	
		rw	

- 7: 0 Receiver FIFO (read access)
- 7: 0 Transmitter FIFO (write access)

## 19.7.2 UART Status Register

Table 143. 0x04 - STAT - UART status register

31	26	25	20	19	11	10	9	8	7	6	5	4	3	2	1	0
RCNT	TCNT		RESERVED			RF	TF	RH	TH	FE	PE	OV	BR	TE	TS	DR
0	0		0			0	0	0	0	0	0	0	0	1	1	0
r	r		r			r	r	r	r	rw	rw	rw	rw	r	r	r

- 31: 26 Receiver FIFO count (RCNT) - shows the number of data frames in the receiver FIFO. Reset: 0
- 25: 20 Transmitter FIFO count (TCNT) - shows the number of data frames in the transmitter FIFO. Reset: 0
- 10 Receiver FIFO full (RF) - indicates that the Receiver FIFO is full. Reset: 0
- 9 Transmitter FIFO full (TF) - indicates that the Transmitter FIFO is full. Reset: 0
- 8 Receiver FIFO half-full (RH) - indicates that at least half of the FIFO is holding data. Reset: 0
- 7 Transmitter FIFO half-full (TH) - indicates that the FIFO is less than half-full. Reset: 0
- 6 Framing error (FE) - indicates that a framing error was detected. Reset: 0
- 5 Parity error (PE) - indicates that a parity error was detected. Reset: 0
- 4 Overrun (OV) - indicates that one or more character have been lost due to overrun. Reset: 0
- 3 Break received (BR) - indicates that a BREAK has been received. Reset: 0
- 2 Transmitter FIFO empty (TE) - indicates that the transmitter FIFO is empty. Reset: 1
- 1 Transmitter shift register empty (TS) - indicates that the transmitter shift register is empty. Reset: 1
- 0 Data ready (DR) - indicates that new data is available in the receiver FIFO. Reset: 0

# LEON3FT Microcontroller

## 19.7.3 UART Control Register

Table 144. UART control register

31	30	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0									
FA	RESERVED											NS	SI	DI	BI	DB	RF	TF	R	LB	FL	PE	PS	TI	RI	TE	RE
1	0											NR	NR	NR	NR	NR	NR	NR	0	NR	0	NR	NR	NR	NR	0	0
r	r											rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw	rw	rw

- 31 FIFOs available (FA) - Set to 1 when receiver and transmitter FIFOs are available.
- 30: 16 RESERVED
- 15 Number of stop bits (NS) - When set to '1' then two stop bits will be used, otherwise one stop bit will be used.
- 14 Transmitter shift register empty interrupt enable (SI) - When set, an interrupt will be generated when the transmitter shift register becomes empty. See section 19.6 for more details.
- 13 Delayed interrupt enable (DI) - When set, delayed receiver interrupts will be enabled and an interrupt will only be generated for received characters after a delay of 4 character times + 4 bits if no new character has been received during that interval. This is only applicable if receiver interrupt enable is set. See section 19.6 for more details.
- 12 Break interrupt enable (BI) - When set, an interrupt will be generated each time a break character is received. See section 19.6 for more details.
- 11 FIFO debug mode enable (DB) - when set, it is possible to read and write the FIFO debug register.
- 10 Receiver FIFO interrupt enable (RF) - when set, Receiver FIFO level interrupts are enabled.
- 9 Transmitter FIFO interrupt enable (TF) - when set, Transmitter FIFO level interrupts are enabled.
- 8 RESERVED and should always be set to '0' for the GR716 device
- 7 Loop back (LB) - if set, loop back mode will be enabled.
- 6 Flow control (FL) - if set, enables flow control using CTS/RTS
- 5 Parity enable (PE) - if set, enables parity generation and checking
- 4 Parity select (PS) - selects parity polarity (0 = even parity, 1 = odd parity)
- 3 Transmitter interrupt enable (TI) - if set, interrupts are generated when characters are transmitted (see section 19.6 for details).
- 2 Receiver interrupt enable (RI) - if set, interrupts are generated when characters are received (see section 19.6 for details).
- 1 Transmitter enable (TE) - if set, enables the transmitter.
- 0 Receiver enable (RE) - if set, enables the receiver.

## 19.7.4 UART Scaler Register

Table 145. 0x0C - SCALER - UART scaler reload register

31	20	19	0
RESERVED		SCALER RELOAD VALUE	
0		NR	
r		rw	

19:0 Scaler reload value

## 19.7.5 UART FIFO Debug Register

Table 146. 0x10 - DEBUG - UART FIFO debug register

31	8	7	0
RESERVED		DATA	
0		NR	
r		rw	

- 7: 0 Transmitter FIFO (read access)
- 7: 0 Receiver FIFO (write access)

# LEON3FT Microcontroller

## 20 Hardware Debug Support Unit

### 20.1 Overview

To simplify debugging on target hardware, the LEON3 processor implements a debug mode during which the pipeline is idle and the processor is controlled through a special debug interface. The LEON3 Debug Support Unit (DSU) is used to control the processor during debug mode. The DSU acts as an AHB slave and can be accessed by any AHB master. An external debug host can therefore access the DSU through several different interfaces.

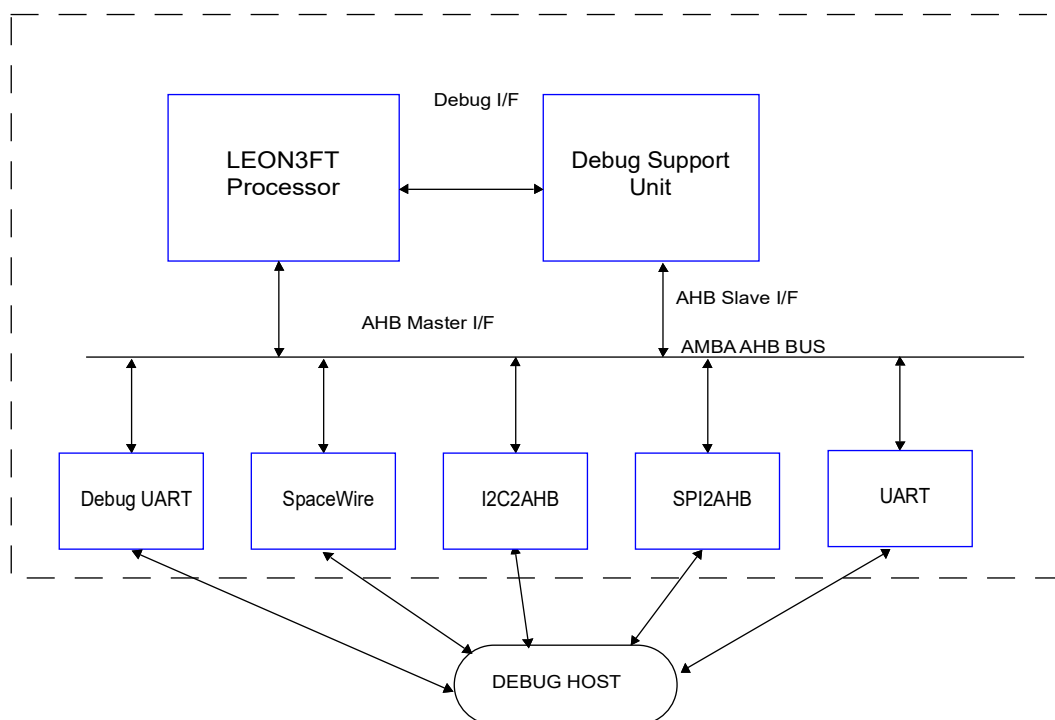


Figure 30. LEON3FT/DSU Connection

### 20.2 Operation

Through the DSU AHB slave interface, any AHB master can access the processor registers and the contents of the instruction trace buffer. The DSU control registers can be accessed at any time, while the processor registers and trace buffer can only be accessed when the processor has entered debug mode. In debug mode, the processor pipeline is held and the processor state can be accessed by the DSU. Entering the debug mode can occur on the following events:

- executing a breakpoint instruction (ta 1)
- integer unit hardware breakpoint/watchpoint hit (trap 0xb)
- rising edge of the external break signal (DSUBRE)
- setting the break-now (BN) bit in the DSU control register
- a trap that would cause the processor to enter error mode
- occurrence of any, or a selection of traps as defined in the DSU control register
- after a single-step operation
- the processor has entered the debug mode
- DSU AHB breakpoint or watchpoint hit

# LEON3FT Microcontroller

The debug mode can only be entered when the debug support unit is enabled through an external signal (DSUEN). For DSU break (DSUBRE), and the break-now BN bit, to have effect the Break-on-IU-watchpoint (BW) bit must be set in the DSU control register. This bit is set when DSUBRE is active after reset and should also be set by debug monitor software (like Frontgrade Gaisler's GRMON) when initializing the DSU. When the debug mode is entered, the following actions are taken:

- PC and nPC are saved in temporary registers (accessible by the debug unit)
- an output signal (DSUACT) is asserted to indicate the debug state
- the timer unit is (optionally) stopped to freeze the LEON timers and watchdog

The instruction that caused the processor to enter debug mode is not executed, and the processor state is kept unmodified. Execution is resumed by clearing the BN bit in the DSU control register or by deasserting DSUEN. The timer unit will be re-enabled and execution will continue from the saved PC and nPC. Debug mode can also be entered after the processor has entered error mode, for instance when an application has terminated and halted the processor. The error mode can be reset and the processor restarted at any address.

When a processor is in the debug mode, an access to ASI diagnostic area is forwarded to the IU which performs access with ASI equal to value in the DSU ASI register and address consisting of 20 LSB bits of the original address.

## 20.3 AHB trace buffer

The AHB trace buffer consists of a circular buffer that stores AHB data transfers, the monitored AHB bus is either the same bus as the DSU AHB slave interface is connected to, or a completely separate bus. The address, data and various control signals of the AHB bus are stored and can be read out for later analysis. The trace buffer is 128 wide. The way information stored is indicated in the table below:

Table 147. AHB Trace buffer data allocation

Bits	Name	Definition
127	AHB breakpoint hit	Set to '1' if a DSU AHB breakpoint hit occurred.
126	-	Not used
125:96	Time tag	DSU time tag counter
95:80	-	Not used
79	Hwrite	AHB HWRITE
78:77	Htrans	AHB HTRANS
76:74	Hsize	AHB HSIZE
73:71	Hburst	AHB HBURST
70:67	Hmaster	AHB HMASTER
66	Hmastlock	AHB HMASTLOCK
65:64	Hresp	AHB HRESP
63:32	Load/Store data	AHB HRDATA/HWDATA(31:0)
31:0	Load/Store address	AHB HADDR

In addition to the AHB signals, the DSU time tag counter is also stored in the trace.

The trace buffer is enabled by setting the enable bit (EN) in the trace control register. Each AHB transfer is then stored in the buffer in a circular manner. The address to which the next transfer is written is held in the trace buffer index register, and is automatically incremented after each transfer. Tracing is stopped when the EN bit is reset, or when a AHB breakpoint is hit. Tracing is temporarily suspended when the processor enters debug mode, unless the trace force bit (TF) in the trace control register is set. If the trace force bit is set, the trace buffer is activated as long as the enable bit is set.

# LEON3FT Microcontroller

The force bit is reset if an AHB breakpoint is hit and can also be cleared by software. Note that neither the trace buffer memory nor the breakpoint registers (see below) can be read/written by software when the trace buffer is enabled.

The DSU has an internal time tag counter and this counter is frozen when the processor enters debug mode. When AHB tracing is performed in debug mode (using the trace force bit) it may be desirable to also enable the time tag counter. This can be done using the timer enable bit (TE). Note that the time tag is also used for the instruction trace buffer and the timer enable bit should only be set when using the DSU as an AHB trace buffer only, and not when performing profiling or software debugging. The timer enable bit is reset on the same events as the trace force bit.

## 20.3.1 AHB trace buffer filters

The DSU is implemented with filters that can be applied to the AHB trace buffer, breakpoints and watchpoints. These filters are controlled via the AHB trace buffer filter control and AHB trace buffer filter mask registers. The fields in these registers allows masking access characteristics such as master, slave, read, write and address range so that accesses that correspond to the specified mask are not written into the trace buffer. Address range masking is done using the second AHB breakpoint register set. The values of the LD and ST fields of this register has no effect on filtering.

## 20.3.2 AHB statistics

The DSU generates statistics from the traced AHB bus. Statistics is collected and output to LEON statistics unit (L3STAT). The statistical outputs can be filtered by the AHB trace buffer filters, this is controlled by the Performance counter Filter bit (PF) in the AHB trace buffer filter control register. The DSU can collect data for the events listed in table 148 below.

Table 148. AHB events

Event	Description	Note
idle	HTRANS=IDLE	Active when HTRANS IDLE is driven on the AHB slave inputs and slave has asserted HREADY.
busy	HTRANS=BUSY	Active when HTRANS BUSY is driven on the AHB slave inputs and slave has asserted HREADY.
nseq	HTRANS=NONSEQ	Active when HTRANS NONSEQ is driven on the AHB slave inputs and slave has asserted HREADY.
seq	HTRANS=SEQ	Active when HTRANS SEQUENTIAL is driven on the AHB slave inputs and slave has asserted HREADY.
read	Read access	Active when HTRANS is SEQUENTIAL or NON-SEQUENTIAL, slave has asserted HREADY and the HWRITE input is low.
write	Write access	Active when HTRANS is SEQUENTIAL or NON-SEQUENTIAL, slave has asserted HREADY and the HWRITE input is high.
hsize[5:0]	Transfer size	Active when HTRANS is SEQUENTIAL or NON-SEQUENTIAL, slave has asserted HREADY and HSIZE is BYTE (hsize[0]), HWORD (HSIZE[1]), WORD (hsize[2]), DWORD (hsize[3]), 4WORD hsize[4], or 8WORD (hsize[5]).
ws	Wait state	Active when HREADY input to AHB slaves is low and AMBA response is OKAY.
retry	RETRY response	Active when master receives RETRY response
split	SPLIT response	Active when master receives SPLIT response



# LEON3FT Microcontroller

Table 148. AHB events

Event	Description	Note
spdel	SPLIT delay	Active during the time a master waits to be granted access to the bus after reception of a SPLIT response. The core will only keep track of one master at a time. This means that when a SPLIT response is detected, the core will save the master index. This event will then be active until the same master is re-allowed into bus arbitration and is granted access to the bus. This also means that the delay measured will include the time for re-arbitration, delays from other ongoing transfers and delays resulting from other masters being granted access to the bus before the SPLIT:ed master is granted again after receiving SPLIT complete.  If another master receives a SPLIT response while this event is active, the SPLIT delay for the second master will not be measured.
locked	Locked access	Active while the HMASTLOCK signal is asserted on the AHB slave inputs.

## 20.4 Instruction trace buffer

The instruction trace buffer consists of a circular buffer that stores executed instructions. The instruction trace buffer is located in the processor, and read out via the DSU. The trace buffer is 128 bits wide, the information stored is indicated in the table below:

Table 149. Instruction trace buffer data allocation

Bits	Name	Definition
127	-	Unused
126	Multi-cycle instruction	Set to '1' on the second and third instance of a multi-cycle instruction (LDD, ST or FPOP)
125:96	Time tag	The value of the DSU time tag counter
95:64	Load/Store parameters	Instruction result, Store address or Store data
63:34	Program counter	Program counter (2 lsb bits removed since they are always zero)
33	Instruction trap	Set to '1' if traced instruction trapped
32	Processor error mode	Set to '1' if the traced instruction caused processor error mode
31:0	Opcode	Instruction opcode

During tracing, one instruction is stored per line in the trace buffer with the exception of multi-cycle instructions. Multi-cycle instructions are entered two or three times in the trace buffer. For store instructions, bits [95:64] correspond to the store address on the first entry and to the stored data on the second entry (and third in case of STD). Bit 126 is set on the second and third entry to indicate this. A double load (LDD) is entered twice in the trace buffer, with bits [95:64] containing the loaded data. Bit 126 is set for the second entry.

When the processor enters debug mode, tracing is suspended. The trace buffer and the trace buffer control register can be read and written while the processor is in the debug mode. During the instruction tracing (processor in normal mode) the trace buffer and trace buffer control register 0 can not be written. The traced instructions can optionally be filtered on instruction types. Which instructions are traced is defined in the instruction trace register [31:28], as defined in the table below:

# LEON3FT Microcontroller

Table 150. Trace filter operation

Trace filter	Instructions traced
0x0	All instructions
0x1	SPARC Fomat 2 instructions
0x2	Control-flow changes. All Call, branch and trap instructions including branch targets
0x4	SPARC Format 1 instructions (CALL)
0x8	SPARC Format 3 instructions except LOAD or STORE
0xC	SPARC Format 3 LOAD or STORE instructions
0xD	SPARC Format 3 LOAD or STORE instructions to alternate space
0xE	SPARC Format 3 LOAD or STORE instructions to alternate space 0x80 - 0xFF

## 20.5 Using the DSU trace buffer

The debug monitor GRMON3 has build-in support for using trace buffer in the DSU. For more information see chapter for using the trace buffer in the GRMON3 User's Manual [GRMON3].

## 20.6 DSU memory map

The DSU memory map can be seen in table 151 below.

Note: The DSU memory interface is intended to be accessed by a debug monitor. Software running on the LEON processors should not access the DSU interface. Registers, such as ASR registers, may not have all fields available via the DSU interface

Table 151. DSU memory map

Address offset	Register
0x000000	DSU control register
0x000008	Time tag counter
0x000020	Break and Single Step register
0x000024	Debug Mode Mask register
0x000040	AHB trace buffer control register
0x000044	AHB trace buffer index register
0x000048	AHB trace buffer filter control register
0x00004c	AHB trace buffer filter mask register
0x000050	AHB breakpoint address 1
0x000054	AHB mask register 1
0x000058	AHB breakpoint address 2
0x00005c	AHB mask register 2
0x100000 - 0x10FFFF	Instruction trace buffer (.0: Trace bits 127 - 96, ..4: Trace bits 95 - 64, ..8: Trace bits 63 - 32, ..C : Trace bits 31 - 0)
0x110000	Instruction Trace buffer control register 0
0x110004	Instruction Trace buffer control register 1
0x200000 - 0x210000	AHB trace buffer (.0: Trace bits 127 - 96, ..4: Trace bits 95 - 64, ..8: Trace bits 63 - 32, ..C : Trace bits 31 - 0)
0x300000 - 0x3007FC	IU register file, port1 (%asr16.dpsel = 0) IU register file, port 2 (%asr16.dpsel = 1)
0x300800 - 0x300FFC	IU register file information for correctable and uncorrectable errors
0x301000 - 0x30107C	FPU register file
0x400000 - 0x4FFFFC	IU special purpose registers

# LEON3FT Microcontroller

Table 151. DSU memory map

Address offset	Register
0x400000	Y register
0x400004	PSR register
0x400008	WIM register
0x40000C	TBR register
0x400010	PC register
0x400014	NPC register
0x400018	FSR register
0x40001C	CPSR register
0x400020	DSU trap register
0x400024	DSU ASI register
0x400040 - 0x40007C	ASR16 - ASR31
0x700000 - 0x7FFFFC	ASI diagnostic access (ASI = value in DSU ASI register, address = address[19:0]) ASI = 0x9 : Local instruction RAM, ASI = 0xB : Local data RAM

## 20.7 DSU registers

### 20.7.1 DSU control register

The DSU is controlled by the DSU control register:

Table 152. 0x000000 - CTRL - DSU control register

31												12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED												PW	HL	PE	EB	EE	DM	BZ	BX	BS	BW	BE	TE	
0												0	0	0	*	*		*	*	*	*	*	*	
r												r	rw	rw	r	r	r	rw	rw	rw	rw	rw	rw	

- 31: 12      Reserved
- 11          Power down (PW) - Returns '1' when processor is in power-down mode.
- 10          Processor halt (HL) - Returns '1' on read when processor is halted. If the processor is in debug mode, setting this bit will put the processor in halt mode.
- 9            Processor error mode (PE) - returns '1' on read when processor is in error mode, else '0'. If written with '1', it will clear the error and halt mode.
- 8            External Break (EB) - Value of the external DSUBRE signal (read-only)
- 7            External Enable (EE) - Value of the external DSUEN signal (read-only)
- 6            Debug mode (DM) - Indicates when the processor has entered debug mode (read-only).
- 5            Break on error traps (BZ) - if set, will force the processor into debug mode on all *except* the following traps: `privileged_instruction`, `fpu_disabled`, `window_overflow`, `window_underflow`, `asynchronous_interrupt`, `ticc_trap`.
- 4            Break on trap (BX) - if set, will force the processor into debug mode when any trap occurs.
- 3            Break on S/W breakpoint (BS) - if set, debug mode will be forced when an breakpoint instruction (ta 1) is executed.
- 2            Break on IU watchpoint (BW) - if set, debug mode will be forced on a IU watchpoint (trap 0xb).
- 1            Break on error (BE) - if set, will force the processor to debug mode when the processor would have entered error condition (trap in trap).
- 0            Trace enable (TE) - Enables instruction tracing. If set the instructions will be stored in the trace buffer. Remains set when then processor enters debug or error mode

# LEON3FT Microcontroller

## 20.7.2 DSU Break and Single Step register

This register is used to break or single step the processor(s).

Table 153.0x000020 - BRSS - BRSS - DSU Break and Single Step register

31	16	15	0
SS[15:0]	BN[15:0]		

- 31: 16      Single step (SSx) - if set, the processor x will execute one instruction and return to debug mode. The bit remains set after the processor goes into the debug mode. As an exception, if the instruction is a branch with the annul bit set, and if the delay instruction is effectively annulled, the processor will execute the branch, the annulled delay instruction and the instruction thereafter before returning to debug mode.
- 15: 0      Break now (BNx) -Force processor x into debug mode if the Break on watchpoint (BW) bit in the processors DSU control register is set. If cleared, the processor x will resume execution.

## 20.7.3 DSU Debug Mode Mask Register

When the processors enters the debug mode the value of the DSU Debug Mode Mask register determines if the other processor is forced in the debug mode.

Table 154.0x000024 - DBGM - DSU Debug Mode Mask register

31	17	16	15	1	0
Reserved	DM	Reserved			ED

- 31: 16      Debug mode mask (DMx) - If set, the processor will not be able to force running processor into debug mode even if it enters debug mode.
- 15: 0      Enter debug mode (ED) - Force processor into debug mode If 0, the processor will not enter the debug mode.

## 20.7.4 DSU trap register

The DSU trap register is a read-only register that indicates which SPARC trap type that caused the processor to enter debug mode. When debug mode is force by setting the BN bit in the DSU control register, the trap type will be 0xb (hardware watchpoint trap).

Table 155.0x400020 - DTR - DSU Trap register

31	13	12	11	4	3	0
RESERVED			EM	TRAPTYPE		R

- 31: 13      RESERVED
- 12          Error mode (EM) - Set if the trap would have cause the processor to enter error mode.
- 11: 4      Trap type (TRAPTYPE) - 8-bit SPARC trap type
- 3: 0        Read as 0x0

## 20.7.5 DSU time tag counter

The trace buffer time tag counter is incremented each clock as long as the processor is running. The counter is stopped when the processor enters debug mode and when the DSU is disabled (unless the

# LEON3FT Microcontroller

timer enable bit in the AHB trace buffer control register is set), and restarted when execution is resumed.

Table 156.0x000008 - DTTC - DSU time tag counter

31	0
TIMETAG	
0	
rw	

31: 0          DSU Time Tag Value (TIMETAG)

The value is used as time tag in the instruction and AHB trace buffer.

## 20.7.6 DSU ASI register

The DSU can perform diagnostic accesses to different ASI areas. The value in the ASI diagnostic access register is used as ASI while the address is supplied from the DSU.

Table 157.0x400024 - DASI - ASI diagnostic access register

31	8	7	0
RESERVED		ASI	
0		NR	
r		rw	

31: 8          RESERVED

7: 0          ASI (ASI) - ASI to be used on diagnostic ASI access

## 20.7.7 AHB Trace buffer control register

The AHB trace buffer is controlled by the AHB trace buffer control register:

Table 158.0x000040 - ATBC - AHB trace buffer control register

31	16	15	8	7	6	5	4	3	2	1	0		
DCNT			RESERVED			DF	SF	TE	TF	BW	BR	DM	EN
0			0			0	0	0	0	0	0	0	0
rw			r			rw	rw	rw	rw	r	rw	rw	rw

31: 16          Trace buffer delay counter (DCNT)

15: 8          RESERVED

7          Sample Force (SF) - If this bit is written to '1' it will have the same effect on the AHB trace buffer as if HREADY was asserted on the bus at the same time as a sequential or non-sequential transfer is made. This means that setting this bit to '1' will cause the values in the trace buffer's sample registers to be written into the trace buffer, and new values will be sampled into the registers. This bit will automatically be cleared after one clock cycle.

Writing to the trace buffer still requires that the trace buffer is enabled (EN bit set to '1') and that the CPU is not in debug mode or that tracing is forced (TF bit set to '1'). This functionality is primarily of interest when the trace buffer is tracing a separate bus and the traced bus appears to have frozen.

6          Timer enable (TE) - Activates time tag counter also in debug mode.

5          Trace force (TF) - Activates trace buffer also in debug mode. Note that the trace buffer must be disabled when reading out trace buffer data via the core's register interface.

4: 3          Bus width (BW) - This value corresponds to log2(Supported bus width / 32)

2          Break (BR) - If set, the processor will be put in debug mode when AHB trace buffer stops due to AHB breakpoint hit.

1          Delay counter mode (DM) - Indicates that the trace buffer is in delay counter mode.

0          Trace enable (EN) - Enables the trace buffer.

# LEON3FT Microcontroller

## 20.7.8 AHB trace buffer index register

The AHB trace buffer index register contains the address of the next trace line to be written.

Table 159.0x000044 - ATBI - AHB trace buffer index register

31		4	3	0
	INDEX			R
	NR			0
	rw			r

- 31: 4      Trace buffer index counter (INDEX)
- 3: 0      Read as 0x0

# LEON3FT Microcontroller

## 20.7.9 AHB trace buffer filter control register

Table 160.0x000048 - ATBFC - AHB trace buffer filter control register

31		14	13	12	11	10	9	8	7		4	3	2	1	0	
RESERVED			WPF	R	BPF	RESERVED			PF	AF	FR	FW				
0			0	0	0	0			0	0	0	0				
r			rw	r	rw	r			rw	rw	rw	rw				

- 31: 14      RESERVED
- 13: 12      AHB watchpoint filtering (WPF) - Bit 13 of this field applies to AHB watchpoint 2 and bit 12 applies to AHB watchpoint 1. If the WPF bit for a watchpoint is set to '1' then the watchpoint will not trigger unless the access also passes through the filter. This functionality can be used to, for instance, set a AHB watchpoint that only triggers if a specified master performs an access to a specified slave.
- 11: 10      RESERVED
- 9: 8        AHB breakpoint filtering (BPF) - Bit 9 of this field applies to AHB breakpoint 2 and bit 8 applies to AHB breakpoint 1. If the BPF bit for a breakpoint is set to '1' then the breakpoint will not trigger unless the access also passes through the filter. This functionality can be used to, for instance, set a AHB breakpoint that only triggers if a specified master performs an access to a specified slave. Note that if a AHB breakpoint is coupled with an AHB watchpoint then the setting of the corresponding bit in this field has no effect.
- 7: 4        RESERVED
- 3            Performance counter Filter (PF) - If this bit is set to '1', the cores performance counter (statistical) outputs will be filtered using the same filter settings as used for the trace buffer. If a filter inhibits a write to the trace buffer, setting this bit to '1' will cause the same filter setting to inhibit the pulse on the statistical output.
- 2            Address Filter (AF) - If this bit is set to '1', only the address range defined by AHB trace buffer breakpoint 2's address and mask will be included in the trace buffer.
- 1            Filter Reads (FR) - If this bit is set to '1', read accesses will not be included in the trace buffer.
- 0            Filter Writes (FW) - If this bit is set to '1', write accesses will not be included in the trace buffer.

## 20.7.10 AHB trace buffer filter mask register

Table 161.0x00004C - ATBFM - AHB trace buffer filter mask register

31		16	15		0
SMASK[15:0]			MMASK[15:0]		
0			0		
rw			rw		

- 31: 16      Slave Mask (SMASK) - If SMASK[n] is set to '1', the trace buffer will not save accesses performed to slave n.
- 15: 0      Master Mask (MMASK) - If MMASK[n] is set to '1', the trace buffer will not save accesses performed by master n.

## 20.7.11 AHB trace buffer breakpoint registers

The DSU contains two breakpoint registers for matching AHB addresses. A breakpoint hit is used to freeze the trace buffer by automatically clearing the enable bit. Freezing can be delayed by programming the DCNT field in the trace buffer control register to a non-zero value. In this case, the DCNT value will be decremented for each additional trace until it reaches zero, after which the trace buffer is frozen. A mask register is associated with each breakpoint, allowing breaking on a block of addresses. Only address bits with the corresponding mask bit set to '1' are compared during breakpoint detection. To break on AHB load or store accesses, the LD and/or ST bits should be set.

Table 162.0x000050, 0x000058 - ATBBA - AHB trace buffer break address register

31		2	1	0
BADDR[31:2]				R

# LEON3FT Microcontroller

Table 162. 0x000050, 0x000058 - ATBBA - AHB trace buffer break address register

NR	0
rw	r

- 31: 2 Break point address (BADDR) - Bits 31:2 of breakpoint address
- 1: 0 Read as 0b00

Table 163. 0x000054, 0x00005C - ATBBM - AHB trace buffer break mask register

31	2	1	0
BMASK[31:2]	LD	ST	
NR	0	0	
rw	rw	rw	

- 31: 2 Breakpoint mask (BMASK) - (see text)
- 1 Load (LD) - Break on data load address
- 0 Store (ST) - Break on data store address

## 20.7.12 Instruction trace control register 0

The instruction trace control register 0 contains a pointer that indicates the next line of the instruction trace buffer to be written.

Table 164. 0x110000 - ITBCO - Instruction trace control register 0

31	29	28	16	15	0
RESERVED			ITPOINTER		
0			NR		
r			rw		

- 31: 28 Trace filter configuration
- 27: 16 RESERVED
- 15: 0 Instruction trace pointer (ITPOINTER)

## 20.7.13 Instruction trace control register 1

The instruction trace control register 1 contains settings used for trace buffer overflow detection. This register can be written while the processor is running.

Table 165. 0x110004 - ITBCI - Instruction trace control register 1

31	28	27	26	24	23	22	0
RESERVED	WO	TLIM	OV	RESERVED			
0	0	0	0	0			
r	rw	rw	rw	r			

- 31: 28 RESERVED
- 27 Watchpoint on overflow (WO) - If this bit is set, and Break on iu watchpoint (BW) is enabled in the DSU control register, then a watchpoint will be inserted when a trace overflow is detected (TOV field in this register gets set).
- 26: 24 Trace Limit (TLIM) - TLIM is compared with the top bits of ITPOINTER in Instruction trace control register 0 to generate the value in the TOV field below.
- 23 Trace Overflow (TOV) - Gets set to '1' when the DSU detects that TLIM equals the top three bits of ITPOINTER.
- 22: 0 RESERVED



# LEON3FT Microcontroller

## 21 On-chip Dual-port Memory with EDAC Protection

The LEON3FT microcontroller have 2 separate Local on-chip SRAM with EDAC (LRAM) units.

Each Local on-chip SRAM with EDAC (LRAM) have a unique control register interface a unique memory address range. AMBA address are described in chapter 2.10.

The Local on-chip SRAM with EDAC (LRAM) control and status register are located on APB bus in the address range from 0x80001000 to 0x80001FFF and from 0x8000B000 to 0x8000BFFF. See Local on-chip SRAM with EDAC (LRAM) units connections in the next drawing.

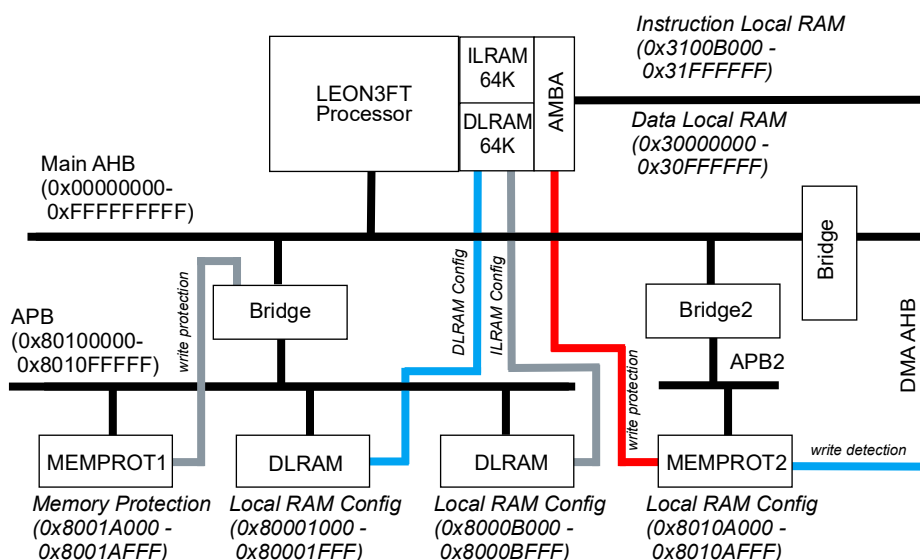


Figure 31. GR716 LRAM bus connection

System can be configured to protect and restrict access to the Local on-chip SRAM with EDAC (LRAM) units configuration and memory area in the **MEMPROT** units. For more information See section 47 for more information.

### 21.1 Overview

The LEON3FT microcontroller includes a 64KiB Dual port SRAM with EDAC for local instruction (ILRAM) execution and 64KiB Dual port SRAM with EDAC for local data storage (DLRAM). This chapter describes the functionality of the instruction and data memory in the LEON3FT microcontroller.

The local instruction and data memory provides the functionality to access the memory directly from the processor and from the DMA AMBA bus. Accesses from the processor have always precedence over accesses made via the DMA AMBA interface. The processor interface and priority scheme guarantees single cycle instruction and data execution in the LEON3FT processor.

The instruction and data memory implements a control interface accessible via the AMBA APB interface. See section 21.2 and 2.10 for register description and base addresses. The instruction and data on-chip memory implements volatile memory that is protected by means of Error Detection And Correction (EDAC). One error can be corrected and two errors can be detected, which is performed by using a (39, 32, 7) BCH code. Some of the optional features available are single error counter, diagnostic reads and writes, scrubbing, automatic correction of single errors during reads. All features are configurable via a configuration register, support for the AMBA protection unit.

Memory areas can be defined and protected from erroneous write accesses. To protect memory segments in the instruction or data memory, protection should be enabled and defined in the AMBA pro-

# LEON3FT Microcontroller

tection unit, see chapter 47. A write to a protected area without write permission to will result in a AMBA error and the write request to the memory will be ignored.

Figure 32 shows a block diagram of the internals of the controller.

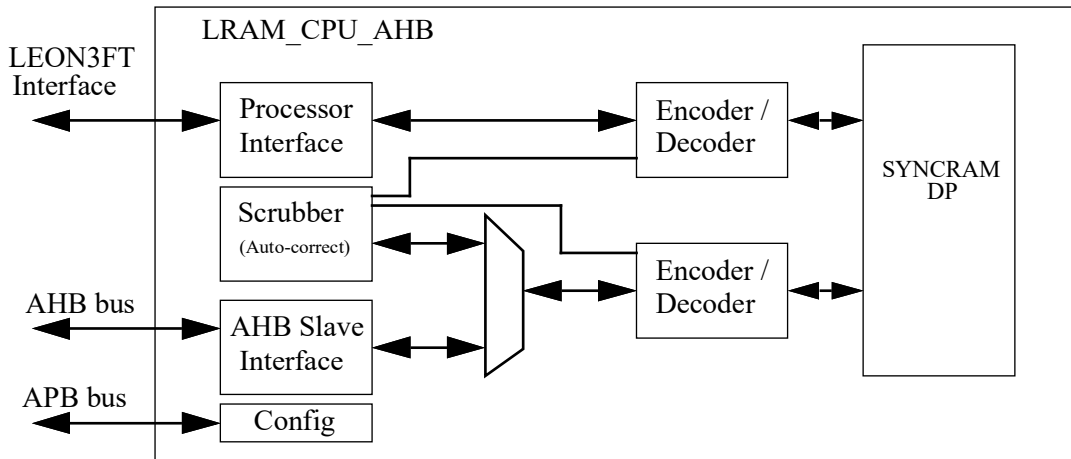


Figure 32. Block diagram

## Operation

The EDAC checksum is always updated for write operations, but only checked during reads when enabled by the LRAMCFG.EN configuration field. When correctable error is detected a counter LRAMCFG.ECNT is incremented and can be used to monitor the error rate.

When a uncorrectable error is detected the read operation will complete with an error response.

### 21.1.1 AHB interface

For single read or the first beat in a read burst the access is performed with 2 wait-states. For the continuing read burst no wait-states are added to the access. Sub-word writes has the same bus timing as single read and the access is performed with 2 wait-states. Sub-word writes are performed as an read-modify-write operation by the memory controller to be able to correctly update the checksum. For word write no wait-states are added. The access on the AHB port could be stalled due to scrub operations or when a write conflict is detected between the AHB port and the CPU port. When the CPU port performs a read to a specific address, a write on the AHB port to the same address is stalled until the CPU read has completed. This feature is enabled by the LRAMCFG.PC configuration field.

Correctable errors are automatically corrected and not visible on the AHB bus (the auto-correction feature can be disabled by the LRAMCFG.ACOR configuration field). When an uncorrectable error is detected the access will terminate with an AMBA ERROR response.

When a write-protected area (defined by the AMBA protection unit) is written the access will be terminated with a AMBA ERROR response.

### 21.1.2 Processor interface

The CPU port is designed to allow word reads and writes with no stalling. Sub-word writes is assumed to be performed as a read-modify-write by the CPU. This port is not affected by the scrubbing operations.

Correctable errors are automatically corrected and not visible for the CPU (the auto-correction feature can be disabled by the LRAMCFG.ACOR configuration field). When an uncorrectable error is detected the access will terminate with a data\_access/store\_exception.

### 21.1.3 Scrubber

The scrubber is designed to loop through all memory locations and check for errors. The scrubbing is performed as a dummy read access which in case of a detected correctable error will trigger the auto-correction feature (which would perform a read-modify-write to update the data and checksum). When an uncorrectable error is detected, the scrubber will not alter the memory location. Instead an interrupt can be generated (by setting the LRAMCFG.IE field to '1'). The scrubber can also be configured to be disabled once an uncorrectable error is detected (by setting the SCRUBCFG.DISE field to '1'). In this case the offset of the failing memory location can be read out from the SCRUBCTRL.ADDR field (this field would in this case point to the memory location directly after the failing location). The scrubbing rate can be configured with the SCRUBCFG.DELAY field. The value of this field sets the number of clock cycles between each scrubbing access.

#### Wash

The scrubber can be configured to wash the memory (writing to all memory location) and generate valid checksums. This is done by setting then SCRUBCFG.WASH field to '1'. To trig the wash function the address, pending, and enable fields need to be set in the scrub control register. The address field should be set to zero to wash the entire memory. When the wash function completes, the scrubber will be automatically enabled to check the memory for errors. To disable the scrubber after the wash has completed, the SCRUBCFG.DISW field needs to be set to '1'.

#### Diagnostic read/write

To perform diagnostic accesses the scrubber is configured to read or write checksum directly using the SCRUBCFG.CB field.

To read out the checksum of a memory location the SCRUBCFG.RCB field needs to be configured to '1'. To perform the read out access, the address and pending bit need to be set in the scrub control register (SCRUBCTRL.ADDR and SCRUBCTRL.PEN). When the access has completed (SCRUBCTRL.PEN = '0') the checksum can be read from the SCRUBCFG.CB field and the corresponding data can be read for the scrub data register.

To write the checksum of a memory location the SCRUBCFG.WCB field needs to be configured to '1' and the SCRUBCFG.CB needs to be set to the checksum. To perform the write access, the address and pending bit need to be set in the scrub control register (SCRUBCTRL.ADDR and SCRUBCTRL.PEN). This would trigger a read-modify-write access to the memory location but instead of using the calculated checksum the value of SCRUBCFG.CB field is used instead.

#### Error injection

To inject error on a memory location the scrubber is configured to xor the checksum with the SCRUBCFG.CB field. This is done by setting the SCRUBCFG.XCB field to '1' and configure the xor pattern in the SCRUBCFG.CB field. To perform the error injection, the address and pending bit need to be set in the scrub control register (SCRUBCTRL.ADDR and SCRUBCTRL.PEN). This would trigger a read-modify-write access to the memory location and xor:ed checksum is written to memory.

# LEON3FT Microcontroller

## 21.2 Local Memory memory map and register

The local memory control registers is programmed via registers mapped into APB address space and the memory area is accessible via processor local interface or via AHB address space.

Table 166. Local Data and Instruction memory map and configuration registers

Address offset and range	Register
0x30000000 - 0x3000FFFF <sup>1) 2)</sup>	Local Data memory area
0x31000000 - 0x3100FFFF <sup>3) 4)</sup>	Local Data memory instruction area
0x80001000	Data memory configuration Register (AHBRAM0.LRAMCFG)
0x80001004	Data memory Scrubber data (AHBRAM0.SCRUBDATA)
0x80001008	Data memory Scrubber control (AHBRAM0.SCRUBCTRL)
0x8000100C	Data memory Scrubber configuration (AHBRAM0.SCRUBCFG)
0x8000B000	Instruction memory configuration Register (AHBRAM1.LRAMCFG)
0x8000B004	Instruction memory Scrubber data AHBRAM1.SCRUBDATA)
0x8000B008	Instruction memory Scrubber control (AHBRAM1.SCRUBCTRL)
0x8000B00C	Instruction memory Scrubber configuration (AHBRAM1.SCRUBCFG)

- 1) LEON3FT processor access address range for data fetch or store via local processor interface. Access is always single cycle access
- 2) LEON3FT processor access address range for Instruction fetch via system and DMA bus interface.
- 3) LEON3FT processor access address range for instruction and data fetch via local processor interface. Access is always single cycle access and data store is restricted.

### 21.2.1 Local Data RAM registers

The core is programmed via registers mapped into APB address space

Table 167. 0x80001000 - AHBRAM0.LRAMCFG - Configuration Register

31	30	29	28	27	24	23	16	15	14	13	12	11	10	9	8	7	4	3	1	0
FT	AOP	SC	RES				MEMSIZE	RES	PC	IE	ACOR	SERR	ECNT		RES	EN				
1	3	1	0				6	0	0	0	0	0	0	0	0	0				
r	r	r	r				r	r	r/w	r/w	r/w	wc	wc		r	r/w				

- 31 FT - EDAC support implemented.
- 30: 29 AOP - Atomic operation implemented for local data RAM.
- 28 SC - Scrubber implemented.
- 27: 24 Reserved.
- 23: 16 MEMSIZE - Memory size is 64 Kbytes. (2<sup>6</sup> Kbytes)
- 15: 14 Reserved.
- 13 PC - Port write conflict detection. When enabled, a write on the AHB port to the same address as the access on the CPU port is stalled.
- 12 IE - Interrupt enable. Enable the assertion of an interrupt when the scrubber detects a un-correctable error.
- 11: 10 ACOR - Auto-correction disable. Disable auto-correction for detected errors. Bit[11]: AHB port, bit[10]: CPU port.
- 9: 8 SERR - Scrub error status. Bit[9] indicates a correctable error is detected by the scrubber. Bit[8] indicates a uncorrectable error is detected by the scrubber. Write '1' to clear.
- 7: 4 ECNT - Correctable error counter. Write '1' to clear.
- 3: 1 Reserved.
- 0 EN - EDAC enable.

# LEON3FT Microcontroller

Table 168. 0x80001004 - AHBRAM0.SCRUBDATA - Scrubber Data Register

31	0
DATA	
n/r	
rw	

31: 0 DATA - Data used by the scrubber in wash mode.

Table 169. 0x80001008 - AHBRAM0.SCRUBCTRL - Scrubber Control Register

31	2	1	0
ADDR	P	S	
0	E	E	
rw	N	N	
	0	0	
	rw	rw	

31: 2 ADDR - Scrubber address offset.  
 1 PEN - Scrub access pending.  
 0 SEN - Scrubber enable.

Table 170. 0x8000100C - AHBRAM0.SCRUBCFG - Scrubber Configuration Register

31	16	15	14	13	12	11	10	4	3	2	1	0
DELAY	RES	D	D	R	CB			W	R	X	W	
0	0	I	I	E	S	S	S	C	C	C	C	A
rw	r	S	S	S	W	E	0	B	B	B	B	S
		W	E	S	rw	rw	rw	rw	rw	rw	rw	H
		0	0	0	rw	rw	rw	rw	rw	rw	rw	0

31: 16 DELAY - Scrubber delay. Delay in clock cycles between each scrub access.  
 15: 14 Reserved.  
 13 DISW - Disable the scrubber after the wash operation is complete.  
 12 DISE - Disable the scrubber when a uncorrectable error is detected.  
 11 Reserved.  
 10: 4 CB - Checksum.  
 3 WCB - Write checksum.  
 2 RCB - Read checksum.  
 1 XCB - XOR checksum with the value of field CB.  
 0 WASH - Enable wash mode.

## 21.2.2 Local Instruction RAM registers

The core is programmed via registers mapped into APB address space

Table 171. 0x8000B000 - AHBRAM1.LRAMCFG - Configuration Register

31	30	29	28	27	24	23	16	15	14	13	12	11	10	9	8	7	4	3	1	0
FT	AOP	SC	RES	MEMSIZE			RES	PC	IE	ACOR	SERR	ECNT		RES		EN				
1	0	1	0	6			0	0	0	0	0	0		0		0				
r	r	r	r	r			r	rw	rw	rw	wc	wc		r		rw				

# LEON3FT Microcontroller

Table 171. 0x8000B000 - AHBRAM1.LRAMCFG - Configuration Register

31	FT - EDAC support implemented.
30: 29	AOP - No Atomic operation implemented for local instruction RAM.
28	SC - Scrubber implemented.
27: 24	Reserved.
23: 16	MEMSIZE - Memory size is 64 Kbytes. (2 <sup>6</sup> Kbytes)
15: 14	Reserved.
13	PC - Port write conflict detection. When enabled, a write on the AHB port to the same address as the access on the CPU port is stalled.
12	IE - Interrupt enable. Enable the assertion of an interrupt when the scrubber detects a un-correctable error.
11: 10	ACOR - Auto-correction disable. Disable auto-correction for detected errors. Bit[11]: AHB port, bit[10]: CPU port.
9: 8	SERR - Scrub error status. Bit[9] indicates a correctable error is detected by the scrubber. Bit[8] indicates a uncorrectable error is detected by the scrubber. Write '1' to clear.
7: 4	ECNT - Correctable error counter. Write '1' to clear.
3: 1	Reserved.
0	EN - EDAC enable.

Table 172. 0x8000B004 - AHBRAM1.SCRUBDATA - Scrubber Data Register

31	0
DATA	
n/r	
rw	

31: 0 DATA - Data used by the scrubber in wash mode.

Table 173. 0x8000B008 - AHBRAM1.SCRUBCTRL - Scrubber Control Register

31	2	1	0
ADDR			P E N
0			S E N
rw			0 0 rw rw

31: 2 ADDR - Scrubber address offset.

1 PEN - Scrub access pending.

0 SEN - Scrubber enable.

Table 174. 0x8000B00C - AHBRAM1.SCRUBCFG - Scrubber Configuration Register

31	16	15	14	13	12	11	10	4	3	2	1	0				
DELAY							RES	D I S W	D I S W	R E S	CB		W C B	R C B	X C B	W A S H
0							0	0	0	0	0		0	0	0	0
rw							r	rw	rw	rw	rw		rw	rw	rw	rw

31: 16 DELAY - Scrubber delay. Delay in clock cycles between each scrub access.

15: 14 Reserved.

# LEON3FT Microcontroller

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Table 174. 0x8000B00C - AHBRAM1.SCRUBCFG - Scrubber Configuration Register

13	DISW - Disable the scrubber after the wash operation is complete.
12	DISE - Disable the scrubber when a uncorrectable error is detected.
11	Reserved.
10: 4	CB - Checksum.
3	WCB - Write checksum.
2	RCB - Read checksum.
1	XCB - XOR checksum with the value of field CB.
0	WASH - Enable wash mode.

# LEON3FT Microcontroller

## 22 Fault Tolerant PROM/SRAM Memory Interface

### 22.1 Overview

The fault tolerant 8-bit memory controller (FTMCTRL) provides a bridge between external memory and the AHB bus. The memory controller can handle two types of devices: PROM, asynchronous static ram (SRAM) The PROM and SRAM areas can be EDAC-protected using a (39,7) BCH code. The BCH code provides single-error correction and double-error detection for each 32-bit memory word.

The memory controller is configured through three configuration registers accessible via an APB bus interface. The PROM and SRAM external data bus is configured in 8-bit mode, for the application requirements.

External chip-selects are provided for up to two PROM bank and four SRAM banks. External PROM are mapped in the address range from 0x01000000 to 0x01FFFFFF and external SRAM in the address range 0x40000000 to 0x4FFFFFFF.

The fault tolerant 8-bit memory controller configuration registers are located on APB bus in the address range from 0x80000000 to 0x80000FFF. See fault tolerant 8-bit memory controller unit connections in the next drawing. The drawing picture memory locations and functions used for fault tolerant 8-bit memory controller configuration and control.

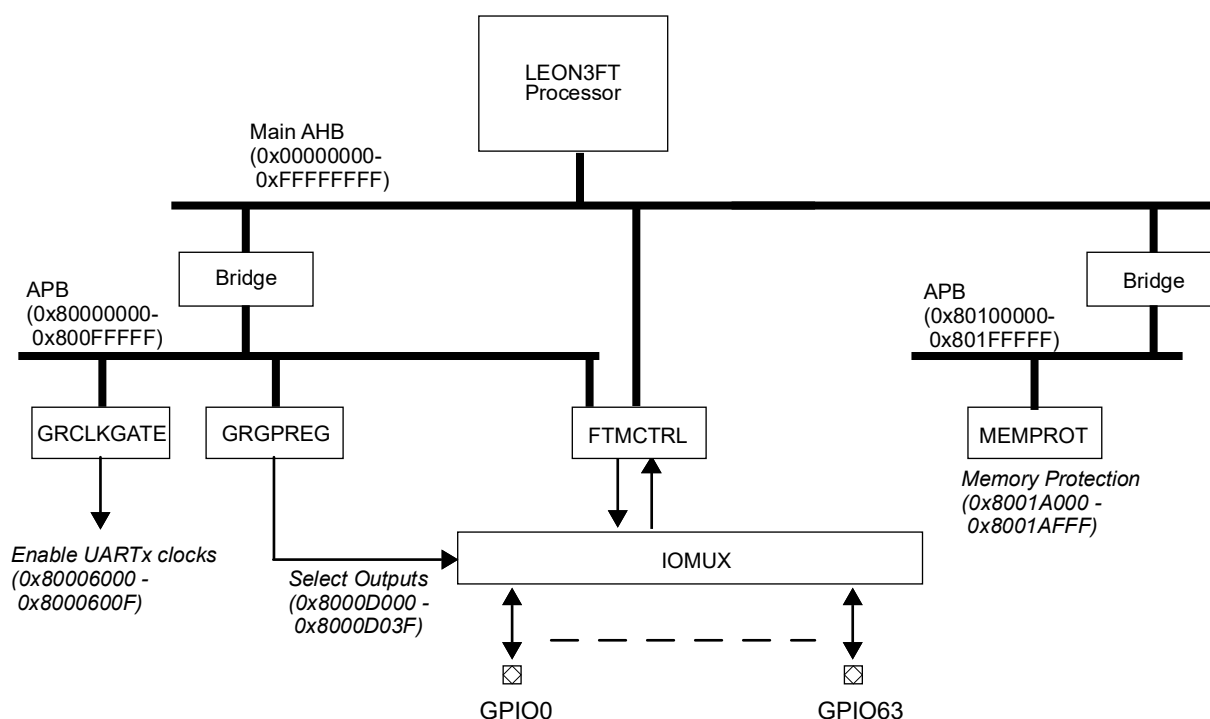


Figure 33. GR716 FTMCTRL bus and pin

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the fault tolerant 8-bit memory controller (FTMCTRL). The unit **GRCLKGATE** can also be used to perform reset of the fault tolerant 8-bit memory controller (FTMCTRL). Software must enable clock and release reset described in section 27 before memory configuration and operations can start.

External IO selection is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.



# LEON3FT Microcontroller

The system can be configured to protect and restrict access to the fault tolerant 8-bit memory controller (FTMCTRL) units in the **MEMPROT** unit. See section 47 for more information.

## 22.2 PROM access

Two external PROM chip-select signals are provided for the PROM area. The size of the banks can be set in binary steps from 16KiB to 256MiB. If the AHB memory area assigned to the memory controller for PROM accesses is larger than the combined size of the memory banks then the PROM memory area will wrap.

A read access to PROM consists of two data cycles and between 0 and 30 waitstates. The read data (and optional EDAC check-bits) are latched on the rising edge of the clock on the last data cycle. On non-consecutive accesses, a idle cycle is placed between the read cycles to prevent bus contention due to slow turn-off time of PROM devices. Figure 34 shows the basic read cycle waveform (zero waitstate) for non-consecutive PROM reads. Note that the address is undefined in the idle cycle. Figure 35 shows the timing for consecutive cycles (zero waitstate). Waitstates are added by extending the data2 phase. This is shown in figure 36 and applies to both consecutive and non-consecutive cycles. Only an even number of waitstates can be assigned to the PROM area.

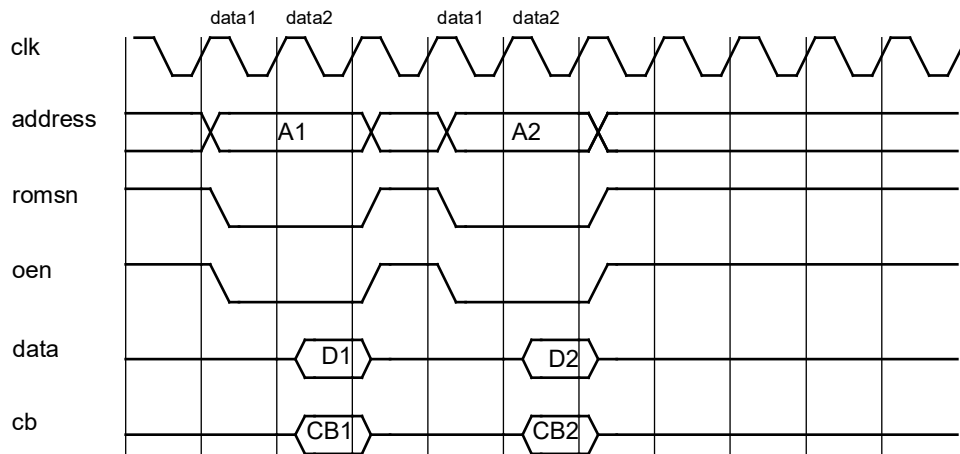


Figure 34. Prom non-consecutive read cycles.

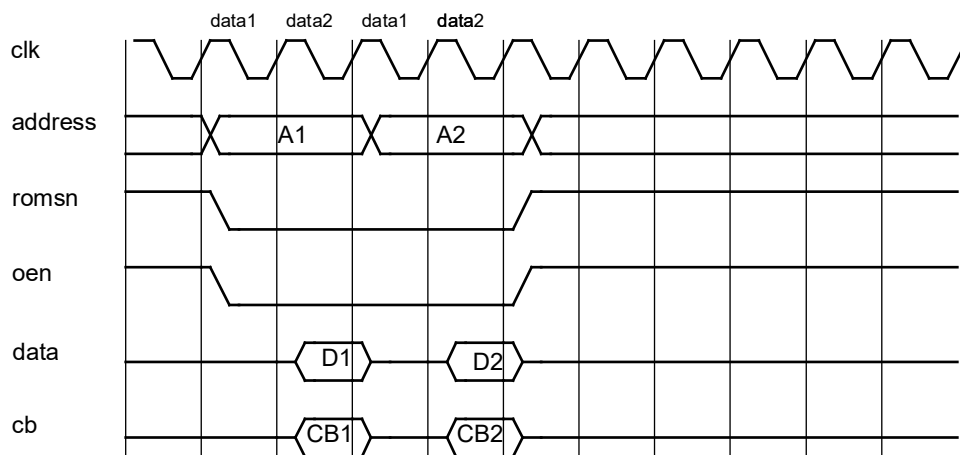


Figure 35. Prom consecutive read cycles.

# LEON3FT Microcontroller

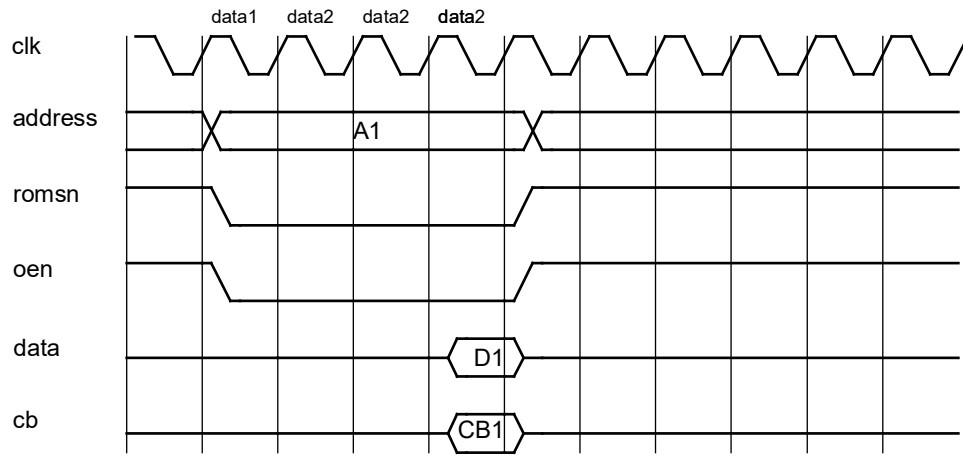


Figure 36. Prom read access with two waitstates.

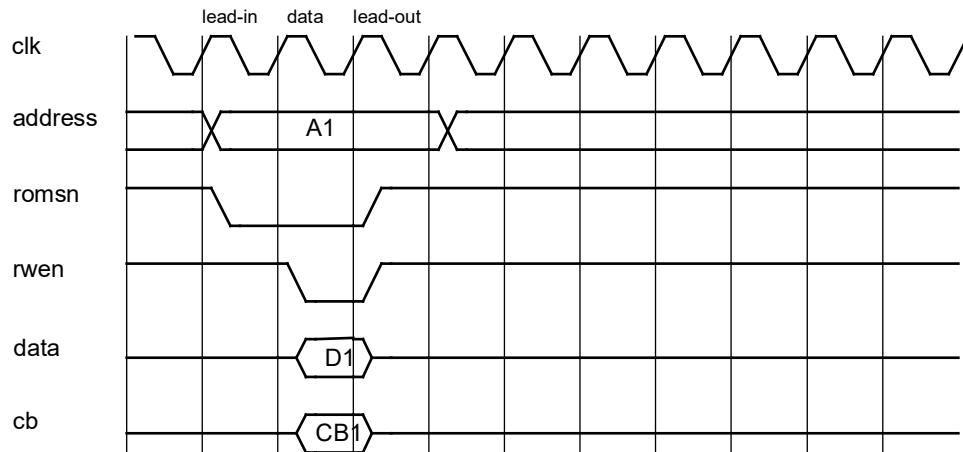


Figure 37. Prom write cycle (0-waitstates)

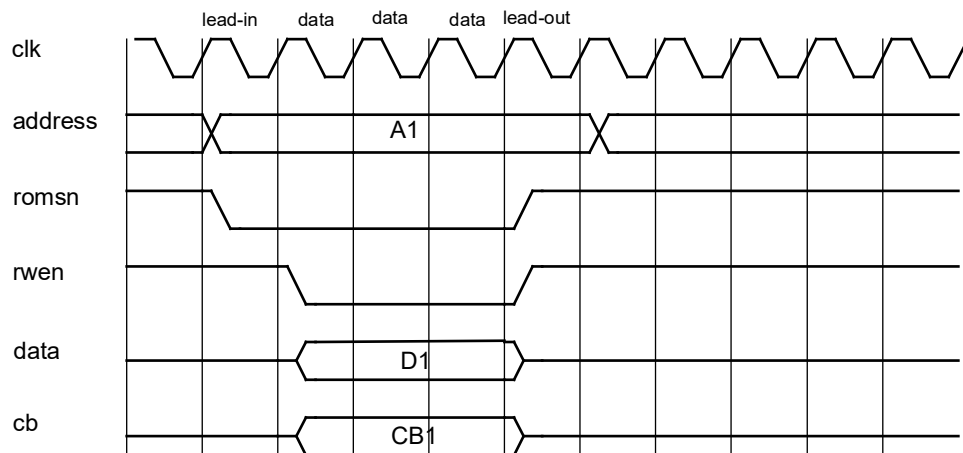


Figure 38. Prom write cycle (2-waitstates)

# LEON3FT Microcontroller

## 22.3 SRAM access

The SRAM area is divided on up to four RAM banks. The size of banks is programmed in the RAM bank-size field (MCFG2[12:9]) and can be set in binary steps from 8KiB to 256MiB. A read access to SRAM consists of two data cycles and between zero and three waitstates. The read data (and optional EDAC check-bits) are latched on the rising edge of the clock on the last data cycle. Accesses to RAM bank four can further be stretched by de-asserting BRDYN until the data is available. On non-consecutive accesses, a idle cycle is added after a read cycle to prevent bus contention due to slow turn-off time of memories. Figure 39 shows the basic read cycle waveform (zero waitstate). Waitstates are added in the same way as for PROM in figure 36.

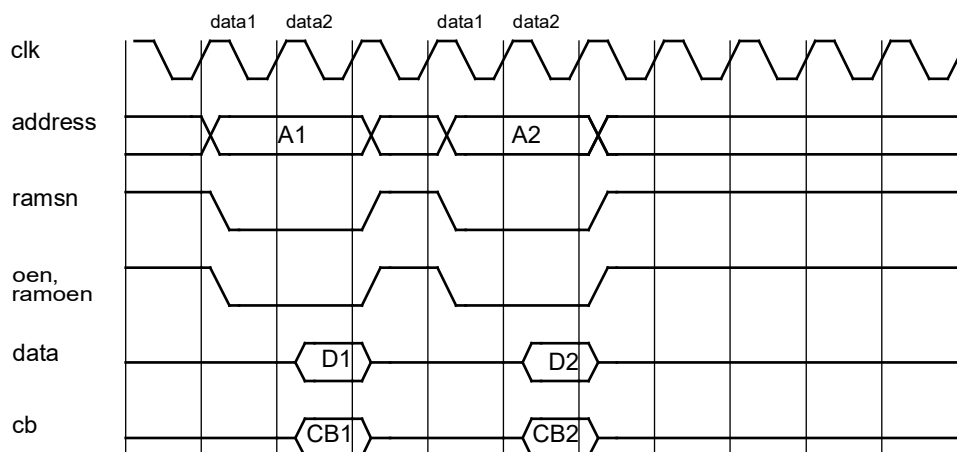


Figure 39. SRAM non-consecutive read cycles.

The SRAM and PROM areas is configured for 8-bit operations. Since reads to memory are always done on 32-bit word basis, read access to 8-bit memory will be transformed in a burst of four read cycles. During writes, only the necessary bytes will be written.

All possible combinations of width, EDAC, and RMW are not supported. The supported combinations are given in table 175, and the behavior of setting an unsupported combination is undefined.

Table 175.FTMCTRL supported SRAM and PROM configurations

PROM/SRAM bus width	RWEN resolution (SRAM)	EDAC	RMW bit (SRAM)	Core configuration
8	Bus width	None	0	8-bit support
8	Bus width	BCH	1	8-bit support, EDAC

## 22.4 Memory EDAC

### 22.4.1 BCH EDAC

The FTMCTRL is provided with an BCH EDAC that can correct one error and detect two errors in a 32-bit word. For each word, a 7-bit checksum is generated according to the equations below. A correctable error will be handled transparently by the memory controller, but adding one waitstate to the access. If an un-correctable error (double-error) is detected, the current AHB cycle will end with an error response. The EDAC can be used during access to PROM and SRAM areas by setting the corresponding EDAC enable bits in the MCFG3 register. The equations below show how the EDAC check-bits are generated:

$$CB0 = D0 \wedge D4 \wedge D6 \wedge D7 \wedge D8 \wedge D9 \wedge D11 \wedge D14 \wedge D17 \wedge D18 \wedge D19 \wedge D21 \wedge D26 \wedge D28 \wedge D29 \wedge D31$$

## LEON3FT Microcontroller

```

CB1 = D0 ^ D1 ^ D2 ^ D4 ^ D6 ^ D8 ^ D10 ^ D12 ^ D16 ^ D17 ^ D18 ^ D20 ^ D22 ^ D24 ^ D26 ^ D28
CB2 = D0 ^ D3 ^ D4 ^ D7 ^ D9 ^ D10 ^ D13 ^ D15 ^ D16 ^ D19 ^ D20 ^ D23 ^ D25 ^ D26 ^ D29 ^ D31
CB3 = D0 ^ D1 ^ D5 ^ D6 ^ D7 ^ D11 ^ D12 ^ D13 ^ D16 ^ D17 ^ D21 ^ D22 ^ D23 ^ D27 ^ D28 ^ D29
CB4 = D2 ^ D3 ^ D4 ^ D5 ^ D6 ^ D7 ^ D14 ^ D15 ^ D18 ^ D19 ^ D20 ^ D21 ^ D22 ^ D23 ^ D30 ^ D31
CB5 = D8 ^ D9 ^ D10 ^ D11 ^ D12 ^ D13 ^ D14 ^ D15 ^ D24 ^ D25 ^ D26 ^ D27 ^ D28 ^ D29 ^ D30 ^ D31
CB6 = D0 ^ D1 ^ D2 ^ D3 ^ D4 ^ D5 ^ D6 ^ D7 ^ D24 ^ D25 ^ D26 ^ D27 ^ D28 ^ D29 ^ D30 ^ D31

```

Data is always accessed as words (4 bytes at a time) and the corresponding checkbits are located at the address acquired by inverting the word address (bits 2 to 27) and using it as a byte address. The same chip-select is kept active. A word written as four bytes to addresses 0, 1, 2, 3 will have its checkbits at address 0xFFFFFFFF, addresses 4, 5, 6, 7 at 0xFFFFFFFFE and so on. All the bits up to the maximum bank size will be inverted while the same chip-select is always asserted. This way all the bank sizes can be supported and no memory will be unused (except for a maximum of 4 byte in the gap between the data and checkbit area). A read access will automatically read the four data bytes individually from the nominal addresses and the EDAC checkbit byte from the top part of the bank. A write cycle is performed the same way. Byte or half-word write accesses will result in an automatic read-modify-write access where 4 data bytes and the checkbit byte are firstly read, and then 4 data bytes and the newly calculated checkbit byte are written back to the memory.

For the ROM the EDAC protection is provided in a similar way as for the SRAM memory described above. The difference is that write accesses are not being handled automatically. Instead, write accesses must only be performed as individual byte accesses by the software, writing one byte at a time, and the corresponding checkbit byte must be calculated and be written to the correct location by the software.

The operation of the EDAC can be tested through the MCFG3 register. If the WB (write bypass) bit is set, the value in the TCB field will replace the normal checkbits during memory write cycles. If the RB (read bypass) is set, the memory checkbits of the loaded data will be stored in the TCB field during memory read cycles. NOTE: when the EDAC is enabled, the RMW bit in memory configuration register 2 must be set.

## 22.5 Bus Ready signalling

The BRDYN signal can be used to stretch all types of access cycles to the PROM and the SRAM area. This covers read and write accesses in general, and additionally read-modify-write accesses to the SRAM area. The accesses will always have at least the pre-programmed number of waitstates as defined in memory configuration registers 1 & 2, but will be further stretched until BRDYN is asserted. BRDYN should be asserted in the cycle preceding the last one. If bit 29 in MCFG1 is set, BRDYN can be asserted asynchronously with the system clock. In this case, the read data must be kept stable until the de-assertion of OEN/RAMOEN and BRDYN must be asserted for at least 1.5 clock cycle. It is recommended that BRDYN is asserted until the corresponding chip select signal is de-asserted, to ensure that the access has been properly completed and avoiding the system to stall.

# LEON3FT Microcontroller

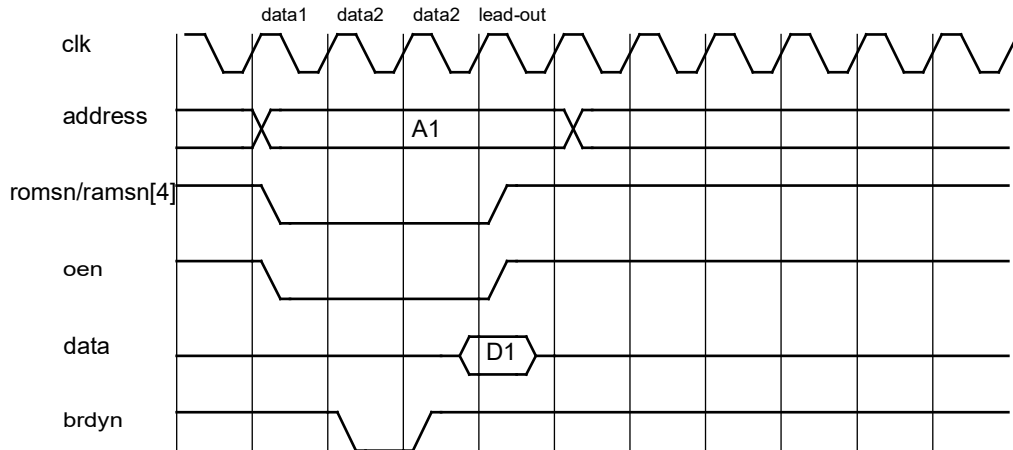


Figure 40. READ cycle with one extra data2 cycle added with BRDYN (synchronous sampling).

Figure 41 shows the use of BRDYN with asynchronous sampling. BRDYN is kept asserted for more than 1.5 clock-cycle. Two synchronization registers are used so it will take at least one additional cycle from when BRDYN is first asserted until it is visible internally. In figure 41 one cycle is added to the data2 phase.

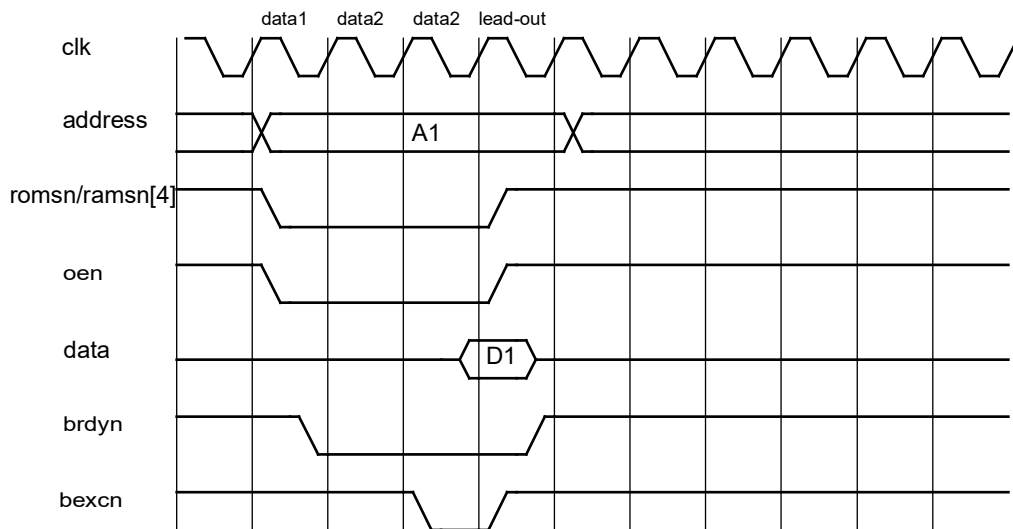


Figure 41. BRDYN (asynchronous) sampling and BEXCN timing.

# LEON3FT Microcontroller

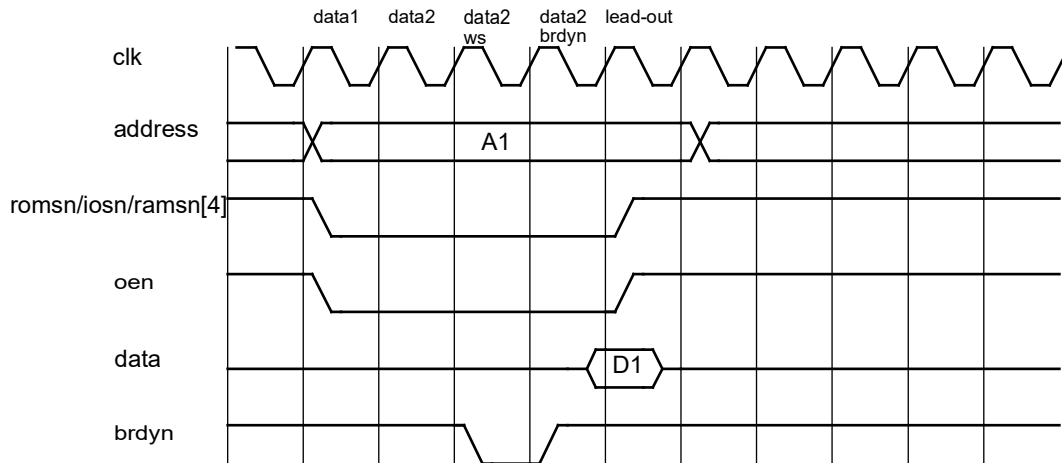


Figure 42. Read cycle with one waitstate (configured) and one BRDYN generated waitstate (synchronous sampling).

If burst accesses and BRDYN signalling are to be used together, special care needs to be taken to make sure BRDYN is raised between the separate accesses of the burst. The controller does not raise the select and OEN signal (in the read case) between accesses during the burst so if BRDYN is kept asserted until the select signal is raised, all remaining accesses in the burst will finish with the configured fixed number of wait states.

## 22.6 Access errors

An access error can be signalled by asserting the BEXCN signal for read and write accesses. For reads it is sampled together with the read data. For writes it is sampled on the last rising edge before chip select is de-asserted, which is controlled by means of waitstates or bus ready signalling. If the usage of BEXCN is enabled in memory configuration register 1, an error response will be generated on the internal AHB bus. BEXCN can be enabled or disabled through memory configuration register 1, and is active for all areas (PROM and RAM).

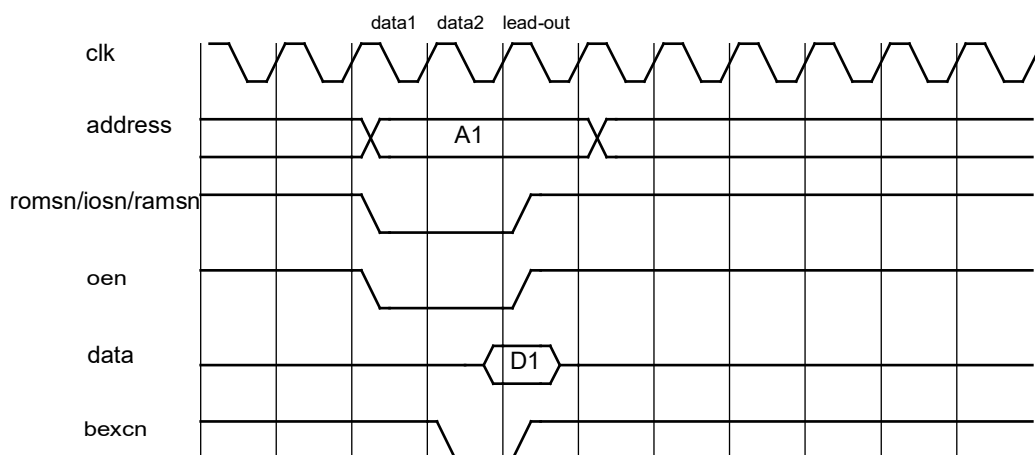


Figure 43. Read cycle with BEXCN.

# LEON3FT Microcontroller

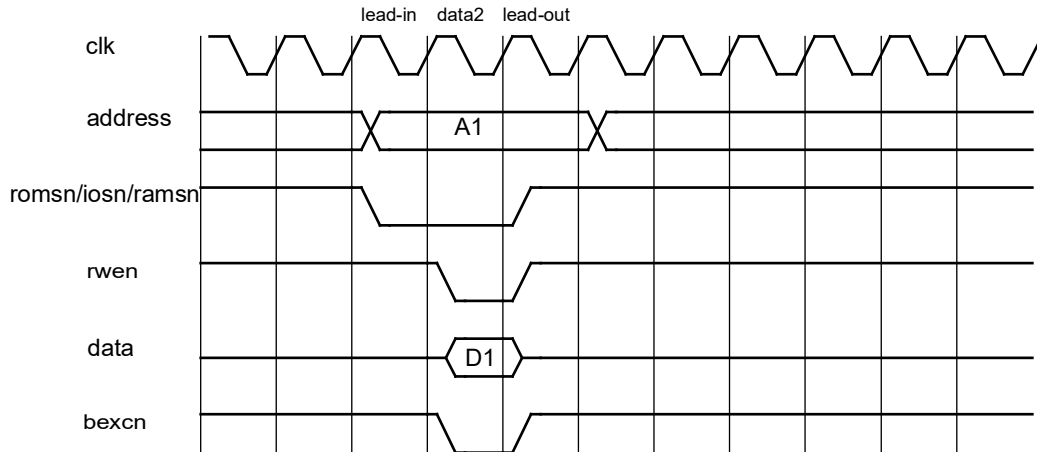


Figure 44. Write cycle with BEXCN. Chip-select (iosn) is not asserted in lead-in cycle for io-accesses.

## 22.7 Registers

The core is programmed through registers mapped into APB address space.

Table 176. FTMCTRL memory controller registers

APB Address offset	Register
0x0	Memory configuration register 1 (MCFG1)
0x4	Memory configuration register 2 (MCFG2)
0x8	Memory configuration register 3 (MCFG3)
0xC	Memory configuration register 4 (MCFG4)
0x10	Memory configuration register 5 (MCFG5)
0x14	Memory configuration register 6 (MCFG6)

### 22.7.1 Memory configuration register 1 (MCFG1)

Memory configuration register 1 is used to program the timing of rom and IO accesses.

Table 177. 0x00 - MCFG1 - Memory configuration register 1

31	30	29	28	27	26	25	24	23	20	19	18	17
R	PBRDY	ABRDY	RESERVED	R	BEXCN	R	RESERVED	IOEN	R	ROMBANKSZ		
0	0	0	NR	0	0	0	0xF	0	0	0x0		
r	rw	rw	rw	rw	rw	r	rw	rw	rw	rw		
14	13	12	11	10	9	8	7	4	3	0		
ROMANKS7	RESERVED	PWEN	RES	PROM WIDTH	PROM WRITE WS	PROM READ WS						
	0	0	0	0	0xF	0xF						
rw	r	rw	r	rw	rw	rw						

- 31 RESERVED
- 30 PROM area bus ready enable (PBRDY) - Enables bus ready (BRDYN) signalling for the PROM area. Reset to '0'.
- 29 Asynchronous bus ready (ABRDY) - Enables asynchronous bus ready.
- 28 : 27 RESERVED
- 26 RESERVED
- 25 Bus error enable (BEXCN) - Enables bus error signalling for all areas. Reset to '0'.
- 24 RESERVED
- 23 : 20 RESERVED

# LEON3FT Microcontroller

Table 177.0x00 - MCFG1 - Memory configuration register 1

19	I/O enable (IOEN) - Enables accesses to the memory bus I/O area. GR716 doesn't provide any I/O area, i.e. for GR716 this bit field shall always be set to '0'.
18	RESERVED
17: 14	PROM bank size (ROMBANKSZ) - Returns current PROM bank size when read. "0000" is a special case and corresponds to a bank size of 256MiB. All other values give the bank size in binary steps: "0001"=16KiB, "0010"=32KiB, "0011"=64KiB,..., "1111"=256MiB (i.e. 8KiB * 2 <sup>^(ROM-BANKSZ)</sup> ). For value "0000" or "1111" only two chip selects are available. For other values, two chip select signals are available for fixed bank sizes. For other values, four chip select signals are available for programmable bank sizes.  Programmable bank sizes can be changed by writing to this register field. The written values correspond to the bank sizes and number of chip-selects as above. Reset to "0000" when programmable.
13:12	RESERVED
11	PROM write enable (PWEN) - Enables write cycles to the PROM area.
10	RESERVED
9 : 8	PROM width (PROM WIDTH) - Sets the data width of the PROM area ("00"=8, "01"=16, "10"=32). For GR716 the data width is locked to 8 bits i.e. for GR716 this bit field shall always be set to "00".
7 : 4	PROM write waitstates (PROM WRITE WS) - Sets the number of wait states for PROM write cycles ("0000"=0, "0001"=2, "0010"=4,..., "1111"=30).
3 : 0	PROM read waitstates (PROM READ WS) - Sets the number of wait states for PROM read cycles ("0000"=0, "0001"=2, "0010"=4,...,"1111"=30). Reset to "1111".

## 22.7.2 Memory configuration register 2 (MCFG2)

Memory configuration register 2 is used to control the timing of the SRAM.

Table 178.0x04 - MLFG2 - Memory configuration register 2

RESERVED													
RESERVED													
RESERVED													
31										16			
15	14	13	12	9	8	7	6	5	4	3	2	1	0
R	R	SI	RAM BANK SIZE	R	RBRDY	RMW	RAM WIDTH	RAM WRITE WS	RAM READ WS				
0	0	0	0x3		0	0	0	3	3				
r	r	rw	rw		rw	rw	rw	rw	rw				

31 : 14	RESERVED
13	SRAM disable (SI) - Disables accesses to SRAM bank if bit 14 (SE) is set to '1'.
12 : 9	RAM bank size (RAM BANK SIZE) - Sets the size of each RAM bank ("0000"=8KiB, "0001"=16KiB, "0010"=32KiB, "0011"= 64KiB,..., "1111"=256MiB)(i.e. (i.e. 8KiB * 2 <sup>^(RAM-BANKSZ)</sup> ).
8	RESERVED
7	RAM bus ready enable (RBRDY) - Enables bus ready signalling for the RAM area.
6	Read-modify-write enable (RMW) - Enables read-modify-write cycles for sub-word writes to 16-bit 32-bit areas with common write strobe (no byte write strobe). Set at reset from external pin.
5 : 4	RAM width (RAM WIDTH) - Sets the data width of the RAM area ("00"=8, "01"=16, "1X"=32). For GR716 the data width is locked to 8 bits i.e. for GR716 this bit field shall always be set to "00".
3 : 2	RAM write waitstates (RAM WRITE WS) - Sets the number of wait states for RAM write cycles ("00"=0, "01"=1, "10"=2, "11"=3).
1 : 0	RAM read waitstates (RAM READ WS) - Sets the number of wait states for RAM read cycles ("00"=0, "01"=1, "10"=2, "11"=3).



# LEON3FT Microcontroller

## 22.7.3 Memory configuration register 3 (MCFG3)

MCFG3 contains the control and monitor the memory EDAC.

Table 179.0x08 - MCFG3 - Memory configuration register 3

31	RESERVED	28	27	26					
	RESERVED		ME		RESERVED				
	0		1						
	r		r						
		12	11	10	9	8	7	0	
	RESERVED		WB	RB	RE	PE	TCB		
			0	0	*	*	NR		
			rw	rw	rw	rw	rw		

- 31 : 28      RESERVED
- 27          Memory EDAC (ME) - Indicates if memory EDAC is present. (read-only)
- 26 : 12      RESERVED
- 11          EDAC diagnostic write bypass (WB) - Enables EDAC write bypass.
- 10          EDAC diagnostic read bypass (RB) - Enables EDAC read bypass.
- 9          RAM EDAC enable (RE) - Enable EDAC checking of the RAM area. Set at reset from external pin
- 8          PROM EDAC enable (PE) - Enable EDAC checking of the PROM area. Set at reset from external pin
- 7 : 0        Test checkbits (TCB) - This field replaces the normal checkbits during write cycles when WB is set. It is also loaded with the memory checkbits during read cycles when RB is set.

## 22.7.4 Memory configuration register 4 (MCFG4)

Table 180.0x0C - MCFG4 - Memory configuration register 4

31	RESERVED										16
15	RESERVED										0

- 31 : 16      RESERVED
- 15 : 0        RESERVED

## 22.7.5 Memory configuration register 5 (MCFG5)

MCFG5 contains fields to control lead out cycles for the ROM areas.

Table 181.0x10 - MCFG5 - Memory configuration register 5

31	30	29						23	22			16	
	RESERVED		RESERVED							RESERVED			
	15	14	13						7	6			0
				ROMHWS							RESERVED		
				0x00									
				rw									

- 31 : 30      RESERVED
- 29:23        RESERVED

# LEON3FT Microcontroller

Table 181.0x10 - MCFG5 - Memory configuration register 5

22 : 14	RESERVED
13:7	ROM lead out (ROMHWS) - Lead out cycles added to ROM accesses are $ROMHWS(3:0)*2^{ROMHWS(6:4)}$
6 : 0	RESERVED

## 22.7.6 Memory configuration register 6 (MCFG6)

MCFG6 contains fields to control lead out cycles for the (S)RAM area.

Table 182.0x14 - MCFG6 - Memory configuration register 6

31	RESERVED												16
0													
r													
15	14	13	7				6						0
RESERVED		RAMHWS						RESERVED					
r		0x00						r					
0		rw						0					

31 : 14	RESERVED
13:7	RAM lead out (RAMHWS) - Lead out cycles added to RAM accesses are $RAMHWS(3:0)*2^{RAMHWS(6:4)}$
6 : 0	RESERVED

## 23 Fault Tolerant NVRAM Memory Interface

This section is reserved to describe the NVRAM controller available to access in-package embedded memory. The LEON3FT microcontroller support up to four chip selects using this type of memory. The memory controller interface is not available on external pins on currently available GR716 models and the documentation for the memory controller is not included in this document. For more information please contact Frontgrade Gaisler.

# LEON3FT Microcontroller

## 24 MIL-STD-1553B / AS15531 Interface

The GR716 microcontroller comprises a MIL-STD-1553B / AS15531 Interface (GR1553B) unit. The MIL-STD-1553B / AS15531 Interface (GR1553B) unit controls its own external pins and has a unique AMBA address described in chapter 2.10.

The MIL-STD-1553B / AS15531 Interface (GR1553B) unit is located on APB bus in the address range from 0x80101000 to 0x80101FFF. See GR1553B unit connections in the next drawing. The drawing picture memory locations and functions used for GR1553B configuration and control.

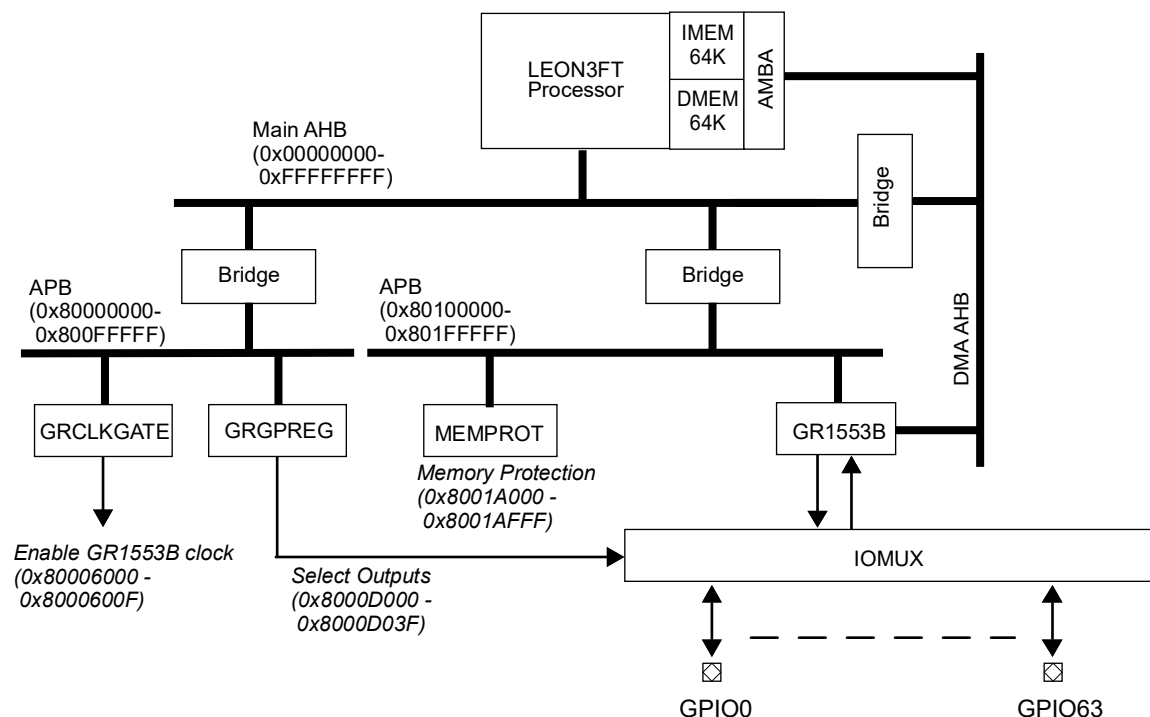


Figure 45. GR716 GR1553B bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the GR1553B unit. The unit **GRCLKGATE** can also be used to perform reset of the GR1553B unit. Software must enable clock and release reset described in section 27 before GR1553B configuration and transmission can start.

External IO selection per GR1553B unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

The **GR1553B** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. Configuration and status registers are described in section 24.7.

The system can be configured to protect and restrict access to GR1553B in the **MEMPROT** unit. See section 47 for more information.

### 24.1 Overview

This interface core connects the AMBA AHB/APB bus to a single- or dual redundant MIL-STD-1553B bus, and can act as either Bus Controller, Remote Terminal or Bus Monitor.

# LEON3FT Microcontroller

MIL-STD-1553B (and derived standard SAE AS15531) is a bus standard for transferring data between up to 32 devices over a shared (typically dual-redundant) differential wire. The bus is designed for predictable real-time behavior and fault-tolerance. The raw bus data rate is fixed at 1 Mbit/s, giving a maximum of around 770 kbit/s payload data rate.

One of the terminals on the bus is the Bus Controller (BC), which controls all traffic on the bus. The other terminals are Remote Terminals (RTs), which act on commands issued by the bus controller. Each RT is assigned a unique address between 0-30. In addition, the bus may have passive Bus Monitors (BM:s) connected.

There are 5 possible data transfer types on the MIL-STD-1553 bus:

- BC-to-RT transfer (“receive”)
- RT-to-BC transfer (“transmit”)
- RT-to-RT transfer
- Broadcast BC-to-RTs
- Broadcast RT-to-RTs

Each transfer can contain 1-32 data words of 16 bits each.

The bus controller can also send “mode codes” to the RTs to perform administrative tasks such as time synchronization, and reading out terminal status.

## 24.2 Electrical interface

The core is connected to the MIL-STD-1553B bus wire through single or dual transceivers, isolation transformers and transformer or stub couplers as shown in figure 46. If single-redundancy is used, the unused bus receive P/N signals should be tied both-high or both-low. The transmitter enables are typically inverted and therefore called transmitter inhibit (txinh).

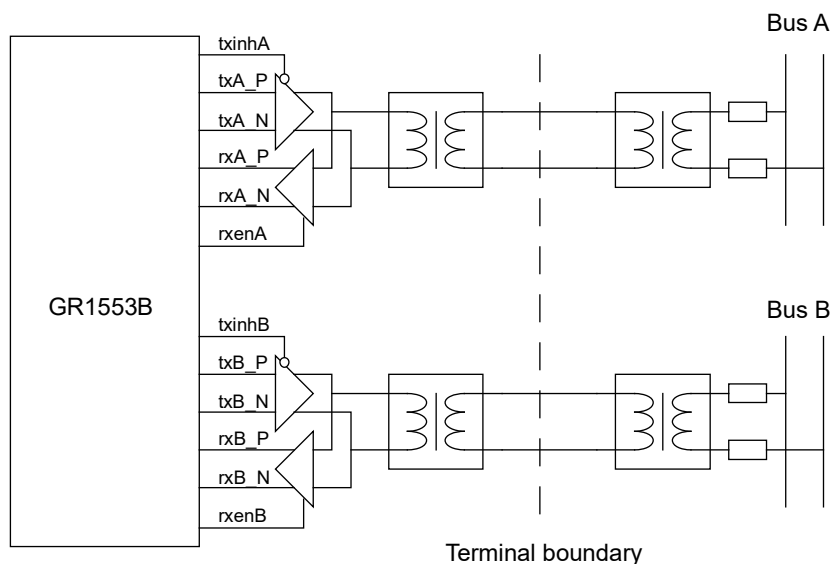


Figure 46. Interface between core and MIL-STD-1553B bus (dual-redundant, transformer coupled)

## 24.3 Operation

### 24.3.1 Operating modes

The core contains three separate control units for the Bus Controller, Remote Terminal and Bus Monitor handling, with a shared 1553 codec.

# LEON3FT Microcontroller

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The operating mode of the core is controlled by starting and stopping of the BC/RT/BM units via register writes. At start-up, none of the parts are enabled, and the core is completely passive on both the 1553 and AMBA bus.

The BC and RT parts of the core can not be active on the 1553 bus at the same time. While the BC is running or suspended, only the BC (and possibly BM) has access to the 1553 bus, and the RT can only receive and respond to commands when both the BC schedules are completely stopped (not running or even suspended).

The Bus Monitor, however, is only listening on the codec receivers and can therefore operate regardless of the enabled/disabled state of the other two parts.

## 24.3.2 Register interface

The core is configured and controlled through control registers accessed over the APB bus. Each of the BC,RT,BM parts has a separate set of registers, plus there is a small set of shared registers.

Some of the control register fields for the BC and RT are protected using a 'key', a field in the same register that has to be written with a certain value for the write to take effect. The purpose of the keys are to give RT/BM designers a way to ensure that the software can not interfere with the bus traffic by enabling the BC or changing the RT address. If the software is built without knowledge of the key to a certain register, it is very unlikely that it will accidentally perform a write with the correct key to that control register.

## 24.3.3 Interrupting

The core has one interrupt output, which can be generated from several different source events. Which events should cause an interrupt can be controlled through the IRQ Enable Mask register.

## 24.3.4 MIL-STD-1553 Codec

The core's internal codec receives and transmits data words on the 1553 bus, and generates and checks sync patterns and parity.

Loop-back checking logic checks that each transmitted word is also seen on the receive inputs. If the transmitted word is not echoed back, the transmitter stops and signals an error condition, which is then reported back to the user.

# LEON3FT Microcontroller

## 24.4 Bus Controller Operation

### 24.4.1 Overview

When operating as Bus Controller, the core acts as master on the MIL-STD-1553 bus, initiates and performs transfers.

This mode works based on a scheduled transfer list concept. The software sets up in memory a sequence of transfer descriptors and branches, data buffers for sent and received data, and an IRQ pointer ring buffer. When the schedule is started (through a BC action register write), the core processes the list, performs the transfers one after another and writes resulting status into the transfer list and incoming data into the corresponding buffers.

### 24.4.2 Timing control

In each transfer descriptor in the schedule is a “slot time” field. If the scheduled transfer finishes sooner than its slot time, the core will pause the remaining time before scheduling the next command. This allows the user to accurately control the message timing during a communication frame.

If the transfer uses more than its slot time, the overshooting time will be subtracted from the following command’s time slot. The following command may in turn borrow time from the following command and so on. The core can keep track of up to one second of borrowed time, and will not insert pauses again until the balance is positive, except for intermessage gaps and pauses that the standard requires.

If you wish to execute the schedule as fast as possible you can set all slot times in the schedule to zero. If you want to group a number of transfers you can move all the slot time to the last transfer.

The schedule can be stopped or suspended by writing into the BC action register. When suspended, the schedule’s time will still be accounted, so that the schedule timing will still be correct when the schedule is resumed. When stopped, on the other hand, the schedule’s timers will be reset.

When the extsync bit is set in the schedule’s next transfer descriptor, the core will wait for a positive edge on the external sync input before starting the command. The schedule timer and the time slot balance will then be reset and the command is started. If the sync pulse arrives before the transfer is reached, it is stored so the command will begin immediately. The trigger memory is cleared when stopping (but not when suspending) the schedule. Also, the trigger can be set/cleared by software through the BC action register.

### 24.4.3 Bus selection

Each transfer descriptor has a bus selection bit that allows you to control on which one of the two redundant buses (‘0’ for bus A, ‘1’ for bus B) the transfer will occur.

Another way to control the bus usage is through the per-RT bus swap register, which has one register bit for each RT address. The bus swap register is an optional feature, software can check the BCFEAT read-only register field to see if it is available.

Writing a ‘1’ to a bit in the per-RT Bus Swap register inverts the meaning of the bus selection bit for all transfers to the corresponding RT, so ‘0’ now means bus ‘B’ and ‘1’ means bus ‘A’. This allows you to switch all transfers to one or a set of RT:s over to the other bus with a single register write and without having to modify any descriptors.

The hardware determines which bus to use by taking the exclusive-or of the bus swap register bit and the bus selection bit. Normally it only makes sense to use one of these two methods for each RT, either the bus selection bit is always zero and the swap register is used, or the swap register bit is always zero and the bus selection bit is used.

If the bus swap register is used for bus selection, the store-bus descriptor bit can be enabled to automatically update the register depending on transfer outcome. If the transfer succeeded on bus A, the bus swap register bit is set to ‘0’, if it succeeds on bus B, the swap register bit is set to ‘1’. If the transfer fails, the bus swap register is set to the opposite value.

# LEON3FT Microcontroller

## 24.4.4 Secondary transfer list

The core can be set up with a secondary “asynchronous” transfer list with the same format as the ordinary schedule. This transfer list can be commanded to start at any time during the ordinary schedule. While the core is waiting for a scheduled command’s slot time to finish, it will check if the next asynchronous transfer’s slot time is lower than the remaining sleep time. In that case, the asynchronous command will be scheduled.

If the asynchronous command doesn’t finish in time, time will be borrowed from the next command in the ordinary schedule. In order to not disturb the ordinary schedule, the slot time for the asynchronous messages must therefore be set to pessimistic values.

The exclusive bit in the transfer descriptor can be set if one does not want an asynchronous command scheduled during the sleep time following the transfer.

Asynchronous messages will not be scheduled while the schedule is waiting for a sync pulse or the schedule is suspended and the current slot time has expired, since it is then not known when the next scheduled command will start.

## 24.4.5 Interrupt generation

Each command in the transfer schedule can be set to generate an interrupt after certain transfers have completed, with or without error. Invalid command descriptors always generate interrupts and stop the schedule. Before a transfer-triggered interrupt is generated, the address to the corresponding descriptor is written into the BC transfer-triggered IRQ ring buffer and the BC Transfer-triggered IRQ Ring Position Register is incremented.

A separate error interrupt signals DMA errors. If a DMA error occurs when reading/writing descriptors, the executing schedule will be suspended. DMA errors in data buffers will cause the corresponding transfer to fail with an error code (see table 186).

Whether any of these interrupt events actually cause an interrupt request on the AMBA bus is controlled by the IRQ Mask Register setting.

## 24.4.6 Transfer list format

The BC:s transfer list is an array of transfer descriptors mixed with branches as shown in table 183. Each entry has to be aligned to start on a 128-bit (16-byte) boundary. The two unused words in the branch case are free to be used by software to store arbitrary data.

Table 183. GR1553B transfer descriptor format

Offset	Value for transfer descriptor	DMA R/W	Value for branch	DMA R/W
0x00	Transfer descriptor word 0 (see table 184)	R	Condition word (see table 188)	R
0x04	Transfer descriptor word 1 (see table 185)	R	Jump address, 128-bit aligned	R
0x08	Data buffer pointer, 16-bit aligned. For write buffers, if bit 0 is set the received data is discarded and the pointer is ignored. This can be used for RT-to-RT transfers where the BC is not interested in the data transferred.	R	Unused	-
0x0C	Result word, written by core (see table 186)	W	Unused	-



# LEON3FT Microcontroller

The transfer descriptor words are structured as shown in tables 184-186 below.

Table 184. GR1553B BC transfer descriptor word 0 (offset 0x00)

31	30	29	28	27	26	25	24	23	22	20	19	18	17	16	15	0
0	WTRIG	EXCL	IRQE	IRQN	SUSE	SUSN	RETMD		NRET	STBUS	GAP	RESERVED			STIME	

- 31 Must be 0 to identify as descriptor
- 30 Wait for external trigger (WTRIG)
- 29 Exclusive time slot (EXCL) - Do not schedule asynchronous messages
- 28 IRQ after transfer on Error (IRQE)
- 27 IRQ normally (IRQN) - Always interrupts after transfer
- 26 Suspend on Error (SUSE) - Suspends the schedule (or stops the async transfer list) on error
- 25 Suspend normally (SUSN) - Always suspends after transfer
- 24 : 23 Retry mode (RETMD). 00 - Retry on same bus only. 01 - Retry alternating on both buses  
10: Retry first on same bus, then on alternating bus. 11 - Reserved, do not use
- 22 : 20 Number of retries (NRET) - Number of automatic retries per bus  
The total number of tries (including the first attempt) is NRET+1 for RETMD=00, 2 x (NRET+1) for RETMD=01/10
- 19 Store bus (STBUS) - If the transfer succeeds and this bit is set, store the bus on which the transfer succeeded (0 for bus A, 1 for bus B) into the per-RT bus swap register. If the transfer fails and this bit is set, store the opposite bus instead. (only if the per-RT bus mask is supported in the core)  
See section 24.4.3 for more information.
- 18 Extended intermessage gap (GAP) - If set, adds an additional amount of gap time, corresponding to the RTTO field, after the transfer
- 17 : 16 Reserved - Set to 0 for forward compatibility
- 15 : 0 Slot time (STIME) - Allocated time in 4 microsecond units, remaining time after transfer will insert delay

Table 185. GR1553B BC transfer descriptor word 1 (offset 0x04)

31	30	29	26	25	21	20	16	15	11	10	9	5	4	0
DUM	BUS	RTTO	RTAD2	RTSA2	RTAD1	TR	RTSA1	WCMC						

- 31 Dummy transfer (DUM) - If set to '1' no bus traffic is generated and transfer "succeeds" immediately  
For dummy transfers, the EXCL,IRQN,SUSN,STBUS,GAP,STIME settings are still in effect, other bits and the data buffer pointer are ignored.
- 30 Bus selection (BUS) - Bus to use for transfer, 0 - Bus A, 1 - Bus B
- 29:26 RT Timeout (RTTO) - Extra RT status word timeout above nominal in units of 4 us (0000 -14 us, 1111 -74 us). Note: This extra time is also used as extra intermessage gap time if the GAP bit is set.
- 25:21 Second RT Address for RT-to-RT transfer (RTAD2) See table 187 for details on how to setup RTAD1,RTSA1,RTAD2,RTSA2,WCMC,TR for different transfer types.
- 20:16 Second RT Subaddress for RT-to-RT transfer (RTSA2)
- 15:11 RT Address (RTAD1)
- 10 Transmit/receive (TR) Note that bits 15:0 correspond to the (first) command word on the 1553 bus
- 9:5 RT Subaddress (RTSA1)
- 4:0 Word count/Mode code (WCMC)

# LEON3FT Microcontroller

Table 186. GR1553B transfer descriptor result word (offset 0x0C)

31	30	24	23	16	15	8	7	4	3	2	0
0	Reserved	RT2ST			RTST		RET CNT		RES	TFRST	

31	Always written as 0
30:24	Reserved - Mask away on read for forward compatibility
23:16	RT 2 Status Bits (RT2ST) - Status bits from receiving RT in RT-to-RT transfer, otherwise 0 Same bit pattern as for RTST below
15:8	RT Status Bits (RTST) - Status bits from RT (transmitting RT in RT-to-RT transfer) 15 - Message error, 14 - Instrumentation bit or reserved bit set, 13 - Service request, 12 - Broadcast command received, 11 - Busy bit, 10 - Subsystem flag, 9 - Dynamic bus control acceptance, 8 - Terminal flag
7:4	Retry count (RET CNT) - Number of retries performed
3	Reserved - Mask away on read for forward compatibility
2:0	Transfer status (TFRST) - Outcome of last try 000 - Success (or dummy bit was set) 001 - RT did not respond (transmitting RT in RT-to-RT transfer) 010 - Receiving RT of RT-to-RT transfer did not respond 011 - A responding RT:s status word had message error, busy, instrumentation or reserved bit set (*) 100 - Protocol error (improperly timed data words, decoder error, wrong number of data words) 101 - The transfer descriptor was invalid 110 - Data buffer DMA timeout or error response 111 - Transfer aborted due to loop back check failure

\* Error code 011 is issued only when the number of data words match the success case, otherwise code 100 is used. Error code 011 can be issued for a correctly executed "transmit last command" or "transmit last status word" mode code since these commands do not reset the status word.

Table 187. GR1553B BC Transfer configuration bits for different transfer types

Transfer type	RTAD1 (15:11)	RTSA1 (9:5)	RTAD2 (25:21)	RTSA2 (20:16)	WCMC (4:0)	TR (10)	Data buffer direction
Data, BC-to-RT	RT address (0-30)	RT subaddr (1-30)	Don't care	0	Word count (0 for 32)	0	Read (2-64 bytes)
Data, RT-to-BC	RT address (0-30)	RT subaddr (1-30)	Don't care	0	Word count (0 for 32)	1	Write (2-64 bytes)
Data, RT-to-RT	Recv-RT addr (0-30)	Recv-RT subad. (1-30)	Xmit-RT addr (0-30)	Xmit-RT subad. (1-30)	Word count (0 for 32)	0	Write (2-64 bytes)
Mode, no data	RT address (0-30)	0 or 31 (*)	Don't care	Don't care	Mode code (0-8)	1	Unused
Mode, RT-to-BC	RT address (0-30)	0 or 31 (*)	Don't care	Don't care	Mode code (16/18/19)	1	Write (2 bytes)
Mode, BC-to-RT	RT address (0-30)	0 or 31 (*)	Don't care	Don't care	Mode code (17/20/21)	0	Read (2 bytes)
Broadcast Data, BC-to-RTs	31	RTs subaddr (1-30)	Don't care	0	Word count (0 for 32)	0	Read (2-64 bytes)
Broadcast Data, RT-to-RTs	31	Recv-RTs subad. (1-30)	Xmit-RT addr (0-30)	Xmit-RT subad. (1-30)	Word count (0 for 32)	0	Write (2-64 bytes)
Broadcast Mode, no data	31	0 or 31 (*)	Don't care	Don't care	Mode code (1, 3-8)	1	Unused
Broadcast Mode, BC-to-RT	31	0 or 31 (*)	Don't care	Don't care	Mode code (17/20/21)	0	Read (2 bytes)

(\*) The standard allows using either of subaddress 0 or 31 for mode commands.

The branch condition word is formed as shown in table 188.

# LEON3FT Microcontroller

Table 188. GR1553B branch condition word (offset 0x00)

31	30	27	26	25	24	23	16	15	8	7	0
1	Reserved (0)	IRQC	ACT	MODE	RT2CC			RTCC		STCC	

31	Must be 1 to identify as branch
30 : 27	Reserved - Set to 0
26	Interrupt if condition met (IRQC)
25	Action (ACT) - What to do if condition is met, 0 - Suspend schedule, 1 - Jump
24	Logic mode (MODE): 0 = Or mode (any bit set in RT2CC, RTCC is set in RT2ST, RTST, or result is in STCC mask) 1 - And mode (all bits set in RT2CC, RTCC are set in RT2ST, RTST and result is in STCC mask)
23:16	RT 2 Condition Code (RT2CC) - Mask with bits corresponding to RT2ST in result word of last transfer
15:8	RT Condition Code (RTCC) - Mask with bits corresponding to RTST in result word of last transfer
7:0	Status Condition Code (STCC) - Mask with bits corresponding to status value of last transfer

Note that you can get a constant true condition by setting `MODE=0` and `STCC=0xFF`, and a constant false condition by setting `STCC=0x00`. `0x800000FF` can thus be used as an end-of-list marker.

# LEON3FT Microcontroller

## 24.5 Remote Terminal Operation

### 24.5.1 Overview

When operating as Remote Terminal, the core acts as a slave on the MIL-STD-1553B bus. It listens for requests to its own RT address (or broadcast transfers), checks whether they are configured as legal and, if legal, performs the corresponding transfer or, if illegal, sets the message error flag in the status word. Legality is controlled by the subaddress control word for data transfers and by the mode code control register for mode codes.

To start the RT, set up the subaddress table and log ring buffer, and then write the address and RT enable bit into the RT Config Register.

### 24.5.2 Data transfer handling

The Remote Terminal mode uses a three-level structure to handle data transfer DMA. The top level is a subaddress table, where each subaddress has a subaddress control word, and pointers to a transmit descriptor and a receive descriptor. Each descriptor in turn contains a descriptor control/status word, pointer to a data buffer, and a pointer to a next descriptor, forming a linked list or ring of descriptors. Data buffers can reside anywhere in memory with 16-bit alignment.

When the RT receives a data transfer request, it checks in the subaddress table that the request is legal. If it is legal, the transfer is then performed with DMA to or from the corresponding data buffer. After a data transfer, the descriptor's control/status word is updated with success or failure status and the subaddress table pointer is changed to point to the next descriptor.

If logging is enabled, a log entry will be written into a log ring buffer area. A transfer-triggered IRQ may also be enabled. To identify which transfer caused the interrupt, the RT Event Log IRQ Position points to the corresponding log entry. For that reason, logging must be enabled in order to enable interrupts.

If a request is legal but can not be fulfilled, either because there is no valid descriptor ready or because the data can not be accessed within the required response time, the core will signal a RT table access error interrupt and not respond to the request. Optionally, the terminal flag status bit can be automatically set on these error conditions.

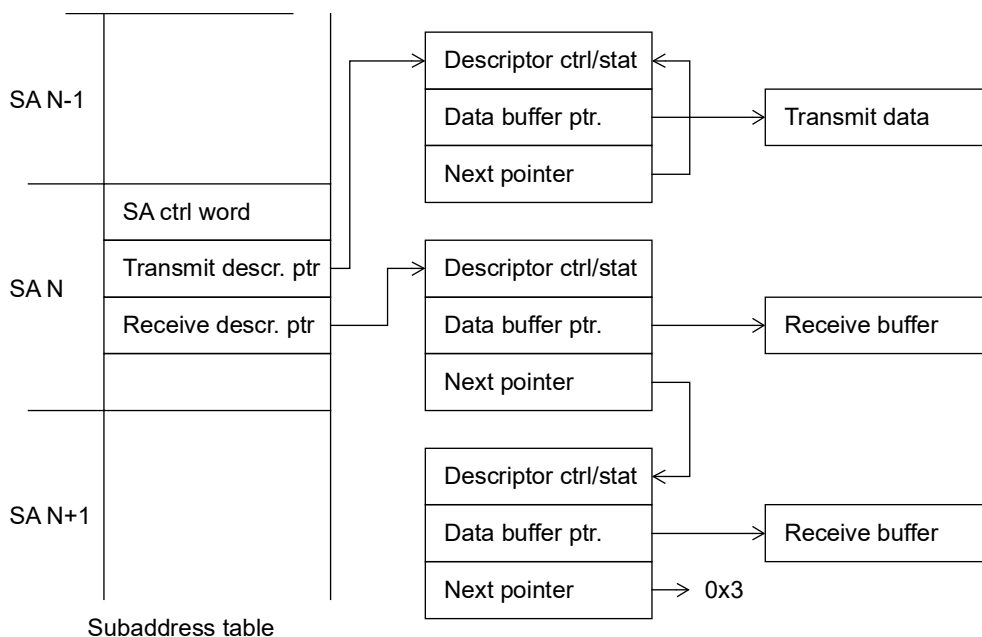


Figure 47. RT subaddress data structure example diagram

# LEON3FT Microcontroller

## 24.5.3 Mode Codes

Which of the MIL-STD-1553B mode codes that are legal and should be logged and interrupted are controlled by the RT Mode Code Control register. As for data transfers, to enable interrupts you must also enable logging. Inhibit mode codes are controlled by the same fields as their non-inhibit counterpart and mode codes that can be broadcast have two separate fields to control the broadcast and non-broadcast variants.

The different mode codes and the corresponding action taken by the RT are tabulated below. Some mode codes do not have a built-in action, so they will need to be implemented in software if desired. The relation between each mode code to the fields in the RT Mode Code control register is also shown.

Table 189. RT Mode Codes

Mode code	Description	Built-in action, if mode code is enabled	Can log/IRQ	Enabled after reset	Ctrl. reg bits	
0	00000	Dynamic bus control	If the DBCA bit is set in the RT Bus Status register, a Dynamic Bus Control Acceptance response is sent.	Yes	No	17:16
1	00001	Synchronize	The time field in the RT sync register is updated. The output rtsync is pulsed high one AMBA cycle.	Yes	Yes	3:0
2	00010	Transmit status word	Transmits the RT:s status word Enabled always, can not be logged or disabled.	No	Yes	-
3	00011	Initiate self test	No built-in action	Yes	No	21:18
4	00100	Transmitter shutdown	The RT will stop responding to commands on the other bus (not the bus on which this command was given).	Yes	Yes	11:8
5	00101	Override transmitter shutdown	Removes the effect of an earlier transmitter shutdown mode code received on the same bus	Yes	Yes	11:8
6	00110	Inhibit terminal flag	Masks the terminal flag of the sent RT status words	Yes	No	25:22
7	00111	Override inhibit terminal flag	Removes the effect of an earlier inhibit terminal flag mode code.	Yes	No	25:22
8	01000	Reset remote terminal	The fail-safe timers, transmitter shutdown and inhibit terminal flag inhibit status are reset. The Terminal Flag and Service Request bits in the RT Bus Status register are cleared. The extreset output is pulsed high one AMBA cycle.	Yes	No	29:26
16	10000	Transmit vector word	Responds with vector word from RT Status Words Register	Yes	No	13:12
17	10001	Synchronize with data word	The time and data fields in the RT sync register are updated. The rtsync output is pulsed high one AMBA cycle	Yes	Yes	7:4
18	10010	Transmit last command	Transmits the last command sent to the RT. Enabled always, can not be logged or disabled.	No	Yes	-
19	10011	Transmit BIT word	Responds with BIT word from RT Status Words Register	Yes	No	15:14
20	10100	Selected transmitter shutdown	No built-in action	No	No	-
21	10101	Override selected transmitter shutdown	No built-in action	No	No	-

# LEON3FT Microcontroller

## 24.5.4 Event Log

The event log is a ring of 32-bit entries, each entry having the format given in table 190. Note that for data transfers, bits 23-0 in the event log are identical to bits 23-0 in the descriptor status word.

Table 190. GR1553B RT Event Log entry format

31	30	29	28	24	23	10	9	8	3	2	0
IRQSR	TYPE	SAMC			TIMEL			BC	SZ		TRES

- 31                    IRQ Source (IRQSRC) - Set to '1' if this transfer caused an interrupt
- 30 : 29            Transfer type (TYPE) - 00 - Transmit data, 01 - Receive data, 10 - Mode code
- 28 : 24            Subaddress / Mode code (SAMC) - If TYPE=00/01 this is the transfer subaddress, If TYPE=10, this is the mode code
- 23 : 10            TIMEL - Low 14 bits of time tag counter.
- 9                    Broadcast (BC) - Set to 1 if request was to the broadcast address
- 8 : 3                Transfer size (SZ) - Count in 16-bit words (0-32)
- 2 : 0                Transfer result (TRES)  
                       000 = Success  
                       001 = Superseded (canceled because a new command was given on the other bus)  
                       010 = DMA error or memory timeout occurred  
                       011 = Protocol error (improperly timed data words or decoder error)  
                       100 = The busy bit or message error bit was set in the transmitted status word and no data was sent  
                       101 = Transfer aborted due to loop back checker error

## 24.5.5 Subaddress table format

Table 191. GR1553B RT Subaddress table entry for subaddress number N, 0<N<31

Offset	Value	DMA R/W
0x10*N + 0x00	Subaddress N control word (table 192)	R
0x10*N + 0x04	Transmit descriptor pointer, 16-byte aligned (0x3 to indicate invalid pointer)	R/W
0x10*N + 0x08	Receive descriptor pointer, 16-byte aligned (0x3 to indicate invalid pointer)	R/W
0x10*N + 0x0C	Unused	-

Note: The table entries for mode code subaddresses 0 and 31 are never accessed by the core.

Table 192. GR1553B RT Subaddress table control word (offset 0x00)

31	19	18	17	16	15	14	13	12	8	7	6	5	4	0
0 (reserved)	WRAP	IGNDV	BCRXE	RXEN	RXLOG	RXIRQ	RXSZ		TXEN	TXLOG	TXIRQ	TXSZ		

- 31 : 19            Reserved - set to 0 for forward compatibility
- 18                    Auto-wraparound enable (WRAP) - Enables a test mode for this subaddress, where transmit transfers send back the last received data. This is done by copying the finished transfer's descriptor pointer to the transmit descriptor pointer address after each successful transfer.  
                       Note: If WRAP=1, you should not set TXSZ > RXSZ as this might cause reading beyond buffer end
- 17                    Ignore data valid bit (IGNDV) - If this is '1' then receive transfers will proceed (and overwrite the buffer) if the receive descriptor has the data valid bit set, instead of not responding to the request.  
                       This can be used for descriptor rings where you don't care if the oldest data is overwritten.
- 16                    Broadcast receive enable (BCRXEN) - Allow broadcast receive transfers to this subaddress
- 15                    Receive enable (RXEN) - Allow receive transfers to this subaddress
- 14                    Log receive transfers (RXLOG) - Log all receive transfers in event log ring (only used if RXEN=1)
- 13                    Interrupt on receive transfers (RXIRQ) - Each receive transfer will cause an interrupt (only if also RXEN,RXLOG=1)
- 12 : 8                Maximum legal receive size (RXSZ) to this subaddress - in 16-bit words, 0 means 32
- 7                      Transmit enable (TXEN) - Allow transmit transfers from this subaddress
- 6                      Log transmit transfers (TXLOG) - Log all transmit transfers in event log ring (only if also TXEN=1)
- 5                      Interrupt on transmit transfers (TXIRQ) - Each transmit transfer will cause an interrupt (only if TXEN,TXLOG=1)
- 4 : 0                Maximum legal transmit size (TXSZ) from this subaddress - in 16-bit words, 0 means 32

# LEON3FT Microcontroller

Table 193. GR1553B RT Descriptor format

Offset	Value	DMA R/W
0x00	Control and status word, see table 194	R/W
0x04	Data buffer pointer, 16-bit aligned	R
0x08	Pointer to next descriptor, 16-byte aligned or 0x0000003 to indicate end of list	R

Table 194. GR1553B RT Descriptor control/status word (offset 0x00)

31	30	29	26	25	10	9	8	3	2	0
DV	IRQEN	Reserved (0)			TIME		BC	SZ		TRES

- 31 Data valid (DV) - Should be set to 0 by software before and set to 1 by hardware after transfer.  
If DV=1 in the current receive descriptor before the receive transfer begins then a descriptor table error will be triggered. You can override this by setting the IGNDV bit in the subaddress table.
- 30 IRQ Enable override (IRQEN) - Log and IRQ after transfer regardless of SA control word settings  
Can be used for getting an interrupt when nearing the end of a descriptor list.
- 29 : 26 Reserved - Write 0 and mask out on read for forward compatibility
- 25 : 10 Transmission time tag (TTIME) - Set by the core to the value of the RT timer when the transfer finished.
- 9 Broadcast (BC) - Set by the core if the transfer was a broadcast transfer
- 8 : 3 Transfer size (SZ) - Count in 16-bit words (0-32)
- 2 : 0 Transfer result (TRES)  
000 = Success  
001 = Superseded (canceled because a new command was given on the other bus)  
010 = DMA error or memory timeout occurred  
011 = Protocol error (improperly timed data words or decoder error)  
100 = The busy bit or message error bit was set in the transmitted status word and no data was sent  
101 = Transfer aborted due to loop back checker error

# LEON3FT Microcontroller

## 24.6 Bus Monitor Operation

### 24.6.1 Overview

The Bus Monitor (BM) can be enabled by itself, or in parallel to the BC or RT. The BM acts as a passive logging device, writing received data with time stamps to a ring buffer.

### 24.6.2 Filtering

The Bus Monitor can also support filtering. This is an optional feature, software can check for this by testing whether the BM filter registers are writable.

Transfers can be filtered per RT address and per subaddress or mode code, and the filter conditions are logically AND:ed. If all bits of the three filter registers and bits 2-3 of the control register are set to '1', the BM core will log all words that are received on the bus.

In order to filter on subaddress/mode code, the BM has logic to track 1553 words belonging to the same message. All 10 message types are supported. If an unexpected word appears, the filter logic will restart. Data words not appearing to belong to any message can be logged by setting a bit in the control register.

The filter logic can be manually restarted by setting the BM enable bit low and then back to high. This feature is mainly to improve testability of the BM itself.

### 24.6.3 No-response handling

In the MIL-STD-1553B protocol, a command word for a mode code using indicator 0 or a regular transfer to subaddress 8 has the same structure as a legal status word. Therefore ambiguity can arise when the subaddress or mode code filters are used, an RT is not responding on a subaddress, and the BC then commands the same RT again on subaddress 8 or mode code indicator 0 on the same bus. This can lead to the second command word being interpreted as a status word and filtered out.

The BM can use the instrumentation bit and reserved bits to disambiguate, which means that this case will never occur when subaddresses 1-7, 9-30 and mode code indicator 31 are used. Also, this case does not occur when the subaddress/mode code filters are unused and only the RT address filter is used.

### 24.6.4 Log entry format

Each log entry is two 32-bit words.

Table 195. GR1553B BM Log entry word 0 (offset 0x00)

31	30	24	23	0
1	Reserved		TIME	

- 31            Always written as 1
- 30 : 24      Reserved - Mask out on read for forward compatibility
- 23 : 0       Time tag (TIME)

Table 196. GR1553B BM Log entry word 1 (offset 0x04)

31	30	20	19	18	17	16	15	0
0	Reserved		BUS	WST	WTP	WD		

- 31            Always written as 0
- 30 : 20      Reserved - Mask out on read for forward compatibility
- 19           Receive data bus (BUS) - 0:A, 1:B
- 18 : 17      Word status (WST) - 00=word OK, 01=Manchester error, 10=Parity error
- 16           Word type (WTP) - 0:Data, 1:Command/status
- 15 : 0       Word data (WD)



# LEON3FT Microcontroller

## 24.7 Registers

The core is programmed through registers mapped into APB address space. Reserved register fields should be written as zeroes and masked out on read.

Table 197. MIL-STD-1553B interface registers

APB address offset	Register	R/W	Reset value
0x00	IRQ Register	RW (write '1' to clear)	0x00000000
0x04	IRQ Enable	RW	0x00000000
0x08...0x0F	(Reserved)		
0x10	Hardware config register	R (constant)	0x00000000*
0x14...0x3F	(Reserved)		
0x40...0x7F	BC Register area (see table 198)		
0x80...0xBF	RT Register area (see table 199)		
0xC0...0xFF	BM Register area (see table 200)		

(\*) May differ depending on core configuration

Table 198. MIL-STD-1553B interface BC-specific registers

APB address offset	Register	R/W	Reset value
0x40	BC Status and Config register	RW	0xf0000000*
0x44	BC Action register	W	
0x48	BC Transfer list next pointer	RW	0x00000000
0x4C	BC Asynchronous list next pointer	RW	0x00000000
0x50	BC Timer register	R	0x00000000
0x54	BC Timer wake-up register	RW	0x00000000
0x58	BC Transfer-triggered IRQ ring position	RW	0x00000000
0x5C	BC Per-RT bus swap register	RW	0x00000000
0x60...0x67	(Reserved)		
0x68	BC Transfer list current slot pointer	R	0x00000000
0x6C	BC Asynchronous list current slot pointer	R	0x00000000
0x70...0x7F	(Reserved)		

(\*) May differ depending on core configuration

# LEON3FT Microcontroller

Table 199. MIL-STD-1553B interface RT-specific registers

APB address offset	Register	R/W	Reset value
0x80	RT Status register	R	0x80000000
0x84	RT Config register	RW	0x0000e03e***
0x88	RT Bus status bits register	RW	0x00000000
0x8C	RT Status words register	RW	0x00000000
0x90	RT Sync register	R	0x00000000
0x94	RT Subaddress table base address	RW	0x00000000
0x98	RT Mode code control register	RW	0x00000555
0x9C...0xA3	(Reserved)		
0xA4	RT Time tag control register	RW	0x00000000
0xA8	(Reserved)		
0xAC	RT Event log size mask	RW	0xffffffffc
0xB0	RT Event log position	RW	0x00000000
0xB4	RT Event log interrupt position	R	0x00000000
0xB8.. 0xBF	(Reserved)		

(\*\*\*) Reset value is affected by the external RTADDR/RTPAR input signals

Table 200. MIL-STD-1553B interface BM-specific registers

APB address offset	Register	R/W	Reset value
0xC0	BM Status register	R	0x80000000
0xC4	BM Control register	RW	0x00000000
0xC8	BM RT Address filter register	RW	0xffffffff
0xCC	BM RT Subaddress filter register	RW	0xffffffff
0xD0	BM RT Mode code filter register	RW	0xffffffff
0xD4	BM Log buffer start	RW	0x00000000
0xD8	BM Log buffer end	RW	0x00000007
0xDC	BM Log buffer position	RW	0x00000000
0xE0	BM Time tag control register	RW	0x00000000
0xE4...0xFF	(Reserved)		

# LEON3FT Microcontroller

## 24.7.1 IRQ Register

Table 201.0x00 - IRQ - GR1553B IRQ Register

31	18	17	16	15	11	10	9	8	7	3	2	1	0
RESERVED	BMTOF	BMD	RESERVED	RTTE	RTD	RTEV	RESERVED	BCWK	BCD	BCEV			
0	0	0	0	0	0	0	0	0	0	0	0	0	0
r	wc	wc	r	wc	wc	wc	r	wc	wc	wc			

Bits read '1' if interrupt occurred, write back '1' to acknowledge

- 17 BM Timer overflow (BMTOF)
- 16 BM DMA Error (BMD)
- 10 RT Table access error (RTTE)
- 9 RT DMA Error (RTD)
- 8 RT transfer-triggered event interrupt (RTEV)
- 2 BC Wake-up timer interrupt (BCWK)
- 1 BC DMA Error (BCD)
- 0 BC Transfer-triggered event interrupt (BCEV)

## 24.7.2 IRQ Enable Register

Table 202.0x04 - IRQE - GR1553B IRQ Enable Register

31	18	17	16	15	11	10	9	8	7	3	2	1	0
RESERVED	BMTOE	BMDE	RESERVED	RTTEE	RTDE	RTEVE	RESERVED	BCWKE	BCDE	BCEVE			
0	0	0	0	0	0	0	0	0	0	0	0	0	0
r	rw	rw	r	rw	rw	rw	r	rw	rw	rw			

- 17 BM Timer overflow interrupt enable (BMTOE)
- 16 BM DMA error interrupt enable (BMDE)
- 10 RT Table access error interrupt enable (RTTEE)
- 9 RT DMA error interrupt enable (RTDE)
- 8 RT Transfer-triggered event interrupt enable (RTEVE)
- 2 BC Wake up timer interrupt (BCWKE)
- 1 BC DMA Error Enable (BCDE)
- 0 BC Transfer-triggered event interrupt (BCEVE)

## 24.7.3 Hardware Configuration Register

Table 203.GR1553B Hardware Configuration Register

31	30	12	11	10	9	8	7	0
MOD	RESERVED	XKEYS	ENDIAN	SCLK	CCFREQ			
0	0	0	0	0	0			
r	r	r	r	r	r			

Note: This register reads 0x0000 for the standard configuration of the core

- 31 Modified (MOD) - Reserved to indicate that the core has been modified / customized in an unspecified manner
- 11 Set if safety keys are enabled for the BM Control Register and for all RT Control Register fields.
- 10 : 9 AHB Endianness - 00=Big-endian, 01=Little-endian, 10/11=Reserved
- 8 Same clock (SCLK) - Reserved for future versions to indicate that the core has been modified to run with a single clock
- 7 : 0 Codec clock frequency (CCFREQ) - Reserved for future versions of the core to indicate that the core runs at a different codec clock frequency. Frequency value in MHz, a value of 0 means 20 MHz.

# LEON3FT Microcontroller

## 24.7.4 BC Status and Config Register

Table 204.0x40 - BCSL - GR1553B BC Status and Config Register

31	30	28	27	17	16	15	11	10	9	8	7	3	2	0
BCSUP	BCFEAT	RESERVED	BCCHK	ASADL	R	ASST	SCADL	SCST						
*	*	0	0	0	0	0	0	0						
r	r	r	rw	r	r	r	r	r						

- 31 BC Supported (BCSUP) - Reads '1' if core supports BC mode
- 30 : 28 BC Features (BCFEAT) - Bit field describing supported optional features ('1'=supported):
  - 30 BC Schedule timer supported
  - 29 BC Schedule time wake-up interrupt supported
  - 28 BC per-RT bus swap register and STBUS descriptor bit supported
- 16 Check broadcasts (BCCHK) - Writable bit, if set to '1' enables waiting and checking for (unexpected) responses to all broadcasts.
- 15 : 11 Asynchronous list address low bits (ASADL) - Bit 8-4 of currently executing (if ASST=01) or next asynchronous command descriptor address
- 9 : 8 Asynchronous list state (ASST) - 00=Stopped, 01=Executing command, 10=Waiting for time slot
- 7 : 3 Schedule address low bits (SCADL) - Bit 8-4 of currently executing (if SCST=001) or next schedule descriptor address
- 2 : 0 Schedule state (SCST) - 000=Stopped, 001=Executing command, 010=Waiting for time slot, 011=Suspended, 100=Waiting for external trigger

## 24.7.5 BC Action Register

Table 205.0x44 - BCA - GR1553B BC Action Register

31	16	15	10	9	8	7	5	4	3	2	1	0
BCKEY	RESERVED	ASSTP	ASSRT	RESERVED	CLRT	SETT	SCSTP	SCSUS	SCSRT			
-	-	-	-	-	-	-	-	-	-	-	-	-
w	-	w	w	-	w	w	w	w	w	w	w	w

- 31 : 16 Safety code (BCKEY) - Must be 0x1552 when writing, otherwise register write is ignored
- 9 Asynchronous list stop (ASSTP) - Write '1' to stop asynchronous list (after current transfer, if executing)
- 8 Asynchronous list start (ASSRT) - Write '1' to start asynchronous list
- 4 Clear external trigger (CLRT) - Write '1' to clear trigger memory
- 3 Set external trigger (SETT) - Write '1' to force the trigger memory to set
- 2 Schedule stop (SCSTP) - Write '1' to stop schedule (after current transfer, if executing)
- 1 Schedule suspend (SCSUS) - Write '1' to suspend schedule (after current transfer, if executing)
- 0 Schedule start (SCSRT) - Write '1' to start schedule

## 24.7.6 BC Transfer List Next Pointer Register

Table 206.0x48 - BCTNP - GR1553B BC Transfer list next pointer register

31	0
SCHEDULE TRANSFER LIST POINTER	
0	
rw	

- 31 : 0 Read: Currently executing (if SCST=001) or next transfer to be executed in regular schedule.  
Write: Change address. If running, this will cause a jump after the current transfer has finished.

# LEON3FT Microcontroller

## 24.7.7 BC Asynchronous List Next Pointer Register

Table 207.0x4C - BCANP - GR1553B BC Asynchronous list next pointer register

31	0
ASYNCHRONOUS LIST POINTER	
0	
rw	

31 : 0      Read: Currently executing (if ASST=01) or next transfer to be executed in asynchronous schedule.  
Write: Change address. If running, this will cause a jump after the current transfer has finished.

## 24.7.8 BC Timer Register

Table 208.0x50 - BCT - GR1553B BC Timer register

31	24	23	0
RESERVED	SCHEDULE TIME (SCTM)		
0	0		
r	r		

23 : 0      Elapsed "transfer list" time in microseconds (read-only)  
Set to zero when schedule is stopped or on external sync.

Note: This register is an optional feature, see BC Status and Config Register, bit 30

## 24.7.9 BC Timer Wake-up Register

Table 209.0x54 - BCTW - GR1553B BC Timer Wake-up register

31	30	24	23	0
WKEN	RESERVED	WAKE-UP TIME (WKTm)		
0	0	0		
rw	r	rw		

31            Wake-up timer enable (WKEN) - If set, an interrupt will be triggered when WKTm=SCTM

23 : 0      Wake-up time (WKTm).

Note: This register is an optional feature, see BC Status and Config Register, bit 29

## 24.7.10 BC Transfer-triggered IRQ Ring Position Register

Table 210.0x58 - BCRD - GR1553B BC Transfer-triggered IRQ ring position register

31	0
BC IRQ SOURCE POINTER RING POSITION	
0	
rw	

31 : 0      The current write pointer into the transfer-triggered IRQ descriptor pointer ring.  
Bits 1:0 are constant zero (4-byte aligned)  
The ring wraps at the 64-byte boundary, so bits 31:6 are only changed by user

# LEON3FT Microcontroller

## 24.7.11 BC per-RT Bus Swap Register

Table 211.0x5C - BCBS - GR1553B BC per-RT Bus swap register

31	0
BC PER-RT BUS SWAP	
0	
rw	

31 : 0 The bus selection value will be logically exclusive-or:ed with the bit in this mask corresponding to the addressed RT (the receiving RT for RT-to-RT transfers). This register gets updated by the core if the STBUS descriptor bit is used.

For more information on how to use this feature, see section 24.4.3.

Note: This register is an optional feature, see BC Status and Config Register, bit 28

## 24.7.12 BC Transfer List Current Slot Pointer

Table 212.0x68 - BCTCP - GR1553B BC Transfer list current slot pointer

31	0
BC TRANSFER SLOT POINTER	
0	
r	

31 : 0 Points to the transfer descriptor corresponding to the current time slot (read-only, only valid while transfer list is running).

Bits 3:0 are constant zero (128-bit/16-byte aligned)

## 24.7.13 BC Asynchronous List Current Slot Pointer

Table 213.0x6C - BCACP - GR1553B BC Asynchronous list current slot pointer

31	0
BC TRANSFER SLOT POINTER	
0	
r	

31 : 0 Points to the transfer descriptor corresponding to the current asynchronous schedule time slot (read-only, only valid while asynchronous list is running).

Bits 3:0 are constant zero (128-bit/16-byte aligned)

## 24.7.14 RT Status Register

Table 214.0x80 - RTS - GR1553B RT Status register (read-only)

31	30	4	3	2	1	0	
RTSUP	RESERVED			ACT	SHDA	SHDB	RUN

31 RT Supported (RTSUP) - Reads '1' if core supports RT mode

3 RT Active (ACT) - '1' if RT is currently processing a transfer

2 Bus A shutdown (SHDA) - Reads '1' if bus A has been shut down by the BC (using the transmitter shutdown mode command on bus B)

1 Bus B shutdown (SHDB) - Reads '1' if bus B has been shut down by the BC (using the transmitter shutdown mode command on bus A)

0 RT Running (RUN) - '1' if the RT is listening to commands.

# LEON3FT Microcontroller

## 24.7.15 RT Config Register

Table 215.0x84 - RTC - GR1553B RT Config register

31	16	15	14	13	12	7	6	5	1	0
RTKEY		SYS	SYDS	BRS	RESERVED		RTEIS	RTADDR		RTEN
0		1	1	1	0		*	*		0
w		rw	rw	rw	r		r	rw		rw

- 31 : 16 Safety code (RTKEY) - Must be written as 0x1553 when changing the RT address, otherwise the address field is unaffected by the write. When reading the register, this field reads 0x0000.  
If extra safety keys are enabled (see Hardware Config Register), the lower half of the key is used to also protect the other fields in this register.
- 15 Sync signal enable (SYS) - Set to '1' to pulse the rtsync output when a synchronize mode code (without data) has been received
- 14 Sync with data signal enable (SYDS) - Set to '1' to pulse the rtsync output when a synchronize with data word mode code has been received
- 13 Bus reset signal enable (BRS) - Set to '1' to pulse the busreset output when a reset remote terminal mode code has been received.
- 6 Reads '1' if current address was set through external inputs.  
After setting the address from software this field is set to '0'
- 5 : 1 RT Address (RTADDR) - This RT:s address (0-30)
- 0 RT Enable (RTEN) - Set to '1' to enable listening for requests

## 24.7.16 RT Bus Status Register

Table 216.0x88 - RTBS - GR1553B RT Bus status register

31	9	8	7	5	4	3	2	1	0
RESERVED		TFDE	RESERVED	SREQ	BUSY	SSF	DBCA	TFLG	
0		0	0	0	0	0	0	0	0
r		rw	rw	rw	rw	rw	rw	rw	rw

- 8 Set Terminal flag automatically on DMA and descriptor table errors (TFDE)
- 4 : 0 These bits will be sent in the RT:s status responses over the 1553 bus.
- 4 Service request (SREQ)
- 3 Busy bit (BUSY)  
Note: If the busy bit is set, the RT will respond with only the status word and the transfer "fails"
- 2 Subsystem Flag (SSF)
- 1 Dynamic Bus Control Acceptance (DBCA)  
Note: This bit is only sent in response to the Dynamic Bus Control mode code
- 0 Terminal Flag (TFLG)  
The BC can mask this flag using the "inhibit terminal flag" mode command, if legal

## 24.7.17 RT Status Words Register

Table 217.0x8C - RTSW - GR1553B RT Status words register

31	16	15	0
BIT WORD (BITW)		VECTOR WORD (VECW)	
0		0	
rw		rw	

- 31 : 16 BIT Word - Transmitted in response to the "Transmit BIT Word" mode command, if legal
- 15 : 0 Vector word - Transmitted in response to the "Transmit vector word" mode command, if legal.

# LEON3FT Microcontroller

## 24.7.18 RT Sync Register

Table 218.0x90 - RTSY - GR1553B RT Sync register

31	16	15	0
SYNC TIME (SYTM)		SYNC DATA (SYD)	
0		0	
r		r	

- 31 : 16      The value of the RT timer at the last sync or sync with data word mode command, if legal.
- 15 : 0      The data received with the last synchronize with data word mode command, if legal

## 24.7.19 Sub Address Table Base Address Register

Table 219.0x94 - RTSTBA - GR1553B RT Sub address table base address register

31	9	8	0
SUBADDRESS TABLE BASE (SATB)		RESERVED	
0		0	
rw		r	

- 31 : 9      Base address, bits 31-9 for subaddress table
- 8 : 0      Always read '0', writing has no effect

## 24.7.20 RT Mode Code Control Register

Table 220.0x98 - RTMCC - GR1553B RT Mode code control register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
RESERVED	RRTB		RRT	ITFB		ITF		ISTB		IST		DBC			
0	0		0	0		0		0		0		0			
r	rw		rw	rw		rw		rw		rw		rw			
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TBW		TVW		TSB		TS		SDB		SD		SB		S	
0		0		1		1		1		1		1		1	
rw		rw		rw		rw		rw		rw		rw		rw	

- For each mode code: "00" - Illegal, "01" - Legal, "10" - Legal, log enabled, "11" - Legal, log and interrupt
- 29 : 28      Reset remote terminal broadcast (RRTB)
- 27 : 26      Reset remote terminal (RRT)
- 25 : 24      Inhibit & override inhibit terminal flag bit broadcast (ITFB)
- 23 : 22      Inhibit & override inhibit terminal flag (ITF)
- 21 : 20      Initiate self test broadcast (ISTB)
- 19 : 18      Initiate self test (IST)
- 17 : 16      Dynamic bus control (DBC)
- 15 : 14      Transmit BIT word (TBW)
- 13 : 12      Transmit vector word (TVW)
- 11 : 10      Transmitter shutdown & override transmitter shutdown broadcast (TSB)
- 9 : 8        Transmitter shutdown & override transmitter shutdown (TS)
- 7 : 6        Synchronize with data word broadcast (SDB)
- 5 : 4        Synchronize with data word (SD)
- 3 : 2        Synchronize broadcast (SB)
- 1 : 0        Synchronize (S)



# LEON3FT Microcontroller

## 24.7.21 RT Time Tag Control Register

Table 221.0xA4 - RTTTC - GR1553B RT Time tag control register

31	16	15	0
TIME RESOLUTION (TRES)		TIME TAG VALUE (TVAL)	
0		0	
rw		rw	

- 31 : 16 Time tag resolution (TRES) - Time unit of RT:s time tag counter in microseconds, minus 1
- 15 : 0 Time tag value (TVAL) - Current value of running time tag counter

## 24.7.22 RT Event Log Mask Register

Table 222.0xAC - RTELM - GR1553B RT Event Log mask register

31	21	20	2	1	0
RESERVED			EVENT LOG SIZE MASK		RES
r			0xFFFFFFFFC		r
r			rw		r

- 31 : 0 Mask determining size and alignment of the RT event log ring buffer. All bits "above" the size should be set to '1', all bits below should be set to '0'

## 24.7.23 RT Event Log Position Register

Table 223.0xB0 - RTELP - GR1553B RT Event Log position register

31	0
EVENT LOG WRITE POINTER	
0	
rw	

- 31 : 0 Address to first unused/oldest entry of event log buffer, 32-bit aligned

## 24.7.24 RT Event Log Interrupt Position Register

Table 224.0xB4 - RTELIP - GR1553B RT Event Log interrupt position register

31	0
EVENT LOG IRQ POINTER	
0	
r	

- 31 : 0 Address to event log entry corresponding to interrupt, 32-bit aligned  
The register is set for the first interrupt and not set again until the interrupt has been acknowledged.

## 24.7.25 BM Status Register

Table 225.0xC0 - BMS - GR1553B BM Status register

31	30	29	0
BMSUP	KEYEN	RESERVED	
*	*	0	
r	r	r	

- 31 BM Supported (BMSUP) - Reads '1' if BM support is in the core.
- 30 Key Enabled (KEYEN) - Reads '1' if the BM validates the BMKEY field when the control register is written.

# LEON3FT Microcontroller

## 24.7.26 BM Control Register

Table 226.0xC4 - BMC - GR1553B BM Control register

31	16	15	6	5	4	3	2	1	0	
BMKEY		RESERVED			WRSTP	EXST	IMCL	UDWL	MANL	BMEN
0		0			0	0	0	0	0	0
rw		r			rw	rw	rw	rw	rw	rw

- 31 : 16 Safety key - If extra safety keys are enabled (see KEYEN), this field must be 0x1543 for a write to be accepted. Is 0x0000 when read.
- 5 Wrap stop (WRSTP) - If set to '1', BMEN will be set to '0' and stop the BM when the BM log position wraps around from buffer end to buffer start
- 4 External sync start (EXST) - If set to '1', BMEN will be set to '1' and the BM is started when an external BC sync pulse is received
- 3 Invalid mode code log (IMCL) - Set to '1' to log invalid or reserved mode codes.
- 2 Unexpected data word logging (UDWL) - Set to '1' to log data words not seeming to be part of any command
- 1 Manchester/parity error logging (MANL) - Set to '1' to log bit decoding errors
- 0 BM Enable (BMEN) - Must be set to '1' to enable any BM logging

## 24.7.27 BMRT Address Filter Register

Table 227.0xC8 - BMRTAF - GR1553B BM RT Address filter register

31	0
ADDRESS FILTER MASK	
0xFFFFFFFF	
rw	

- 31 Enables logging of broadcast transfers
- 30 : 0 Each bit position set to '1' enables logging of transfers with the corresponding RT address

## 24.7.28 BMRT Sub address Filter Register

Table 228.0xCC - BMRTSF - GR1553B BM RT Sub address filter register

31	0
SUBADDRESS FILTER MASK	
0xFFFFFFFF	
rw	

- 31 Enables logging of mode commands on sub address 31
- 30 : 1 Each bit position set to '1' enables logging of transfers with the corresponding RT sub address
- 0 Enables logging of mode commands on sub address 0

# LEON3FT Microcontroller

## 24.7.29 BMRT Mode Code Filter Register

Table 229.0xCC - BMRTMC - GR1553B BM RT Mode code filter register

31													19	18	17	16
RESERVED													STSB	STS	TLC	
0x1ttt													1	1	1	
r													rw	rw	rw	

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TSW	RRTB	RRT	ITFB	ITF	ISTB	IST	DBC	TBW	TVW	TSB	TS	SDB	SD	SB	S
1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

Each bit set to '1' enables logging of a mode code:

- 18 Selected transmitter shutdown broadcast & override selected transmitter shutdown broadcast (STSB)
- 17 Selected transmitter shutdown & override selected transmitter shutdown (STS)
- 16 Transmit last command (TLC)
- 15 Transmit status word (TSW)
- 14 Reset remote terminal broadcast (RRTB)
- 13 Reset remote terminal (RRT)
- 12 Inhibit & override inhibit terminal flag bit broadcast (ITFB)
- 11 Inhibit & override inhibit terminal flag (ITF)
- 10 Initiate self test broadcast (ISTB)
- 9 Initiate self test (IST)
- 8 Dynamic bus control (DBC)
- 7 Transmit BIT word (TBW)
- 6 Transmit vector word (TVW)
- 5 Transmitter shutdown & override transmitter shutdown broadcast (TSB)
- 4 Transmitter shutdown & override transmitter shutdown (TS)
- 3 Synchronize with data word broadcast (SDB)
- 2 Synchronize with data word (SD)
- 1 Synchronize broadcast (SB)
- 0 Synchronize (S)

## 24.7.30 BMLog Buffer Start

Table 230.0xD4 - BMLBS - GR1553B BM Log buffer start

31															0
BM LOG BUFFER START															
0															
rw															

- 31 : 0 Pointer to the lowest address of the BM log buffer (8-byte aligned)  
Due to alignment, bits 2:0 are always 0.

## 24.7.31 BMLog Buffer End

Table 231.0xD8 - BMLBE - GR1553B BM Log buffer end

31											22		21		3			2		0			
-											BM LOG BUFFER END											-	
0x0000007											0x0000007											-	
r											rw											r	

- 31 : 0 Pointer to the highest address of the BM log buffer  
Only bits 21:3 are settable, i.e. the buffer can not cross a 4 MB boundary Bits 31:22 read the same as the buffer start address. Due to alignment, bits 2:0 are always equal to 1

# LEON3FT Microcontroller

## 24.7.32 BMLog Buffer Position

Table 232.0xDC - BMLBP - GR1553B BM Log buffer position

31	22	21	3	2	0
-	BM LOG BUFFER POSITION			-	
0x00000000					
r	rw			r	

31 : 0      Pointer to the next position that will be written to in the BM log buffer  
 Only bits 21:3 are settable, i.e. the buffer can not cross a 4 MB boundary Bits 31:22 read the same as the buffer start address. Due to alignment, bits 2:0 are always equal to 0

## 24.7.33 BM Time Tag Control Register

Table 233.0xE0 - BMTTC - GR1553B BM Time tag control register

31	24	23	0
TIME TAG RESOLUTION		TIME TAG VALUE	
0		0	
rw		rw	

31 : 24      Time tag resolution (TRES) - Time unit of BM:s time tag counter in microseconds, minus 1  
 23 : 0      Time tag value (TVAL) - Current value of running time tag counter

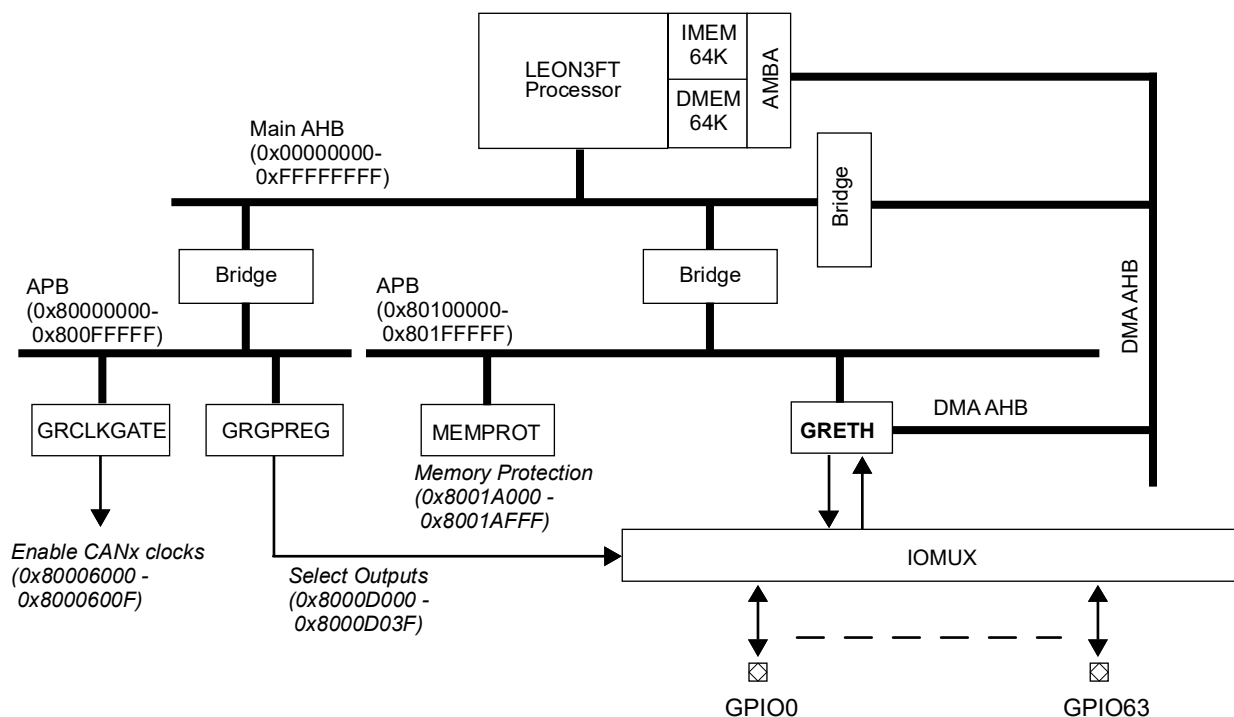
# LEON3FT Microcontroller

## 25 Ethernet Media Access Controller (MAC)

The GR716B microcontroller contains one Ethernet controller unit. The controller unit controls its own external pins and has a unique AMBA address described in chapter 2.10. The GRETH configuration and status registers are described in section 25.7.

The Ethernet controller units are located on APB bus in the address range from 0x80109000 to 0x80109FFF. See GRETH0 unit connections in the next drawing. The drawing picture provides memory locations and functions used for GRETH configuration and control.

Figure 48. GR716B GRETH bus and pin connection



The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the GRETH unit. The unit **GRCLKGATE** can also be used to perform reset of the GRETH unit. Software must enable clock and release reset described in section 27 before GRETH configuration and transmission can start.

External IO selection per GRETH unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

System can be configured to protect and restrict access to individual GRETH units in the **MEMPROT** unit. See section 47 for more information.

### 25.1 Overview

Frontgrade Gaisler’s Ethernet Media Access Controller (GRETH) provides an interface between an AMBA-AHB bus and an Ethernet network. It supports 10/100 Mbit speed in both full- and half-duplex. The AMBA interface consists of an APB interface for configuration and control and an AHB master interface which handles the dataflow. The dataflow is handled through DMA channels. There is one DMA engine for the transmitter and one for the receiver. Both share the same AHB master interface. The ethernet interface supports the MII interfaces which should be connected to an external PHY. The GRETH also provides access to the MII Management interface which is used to configure the PHY.

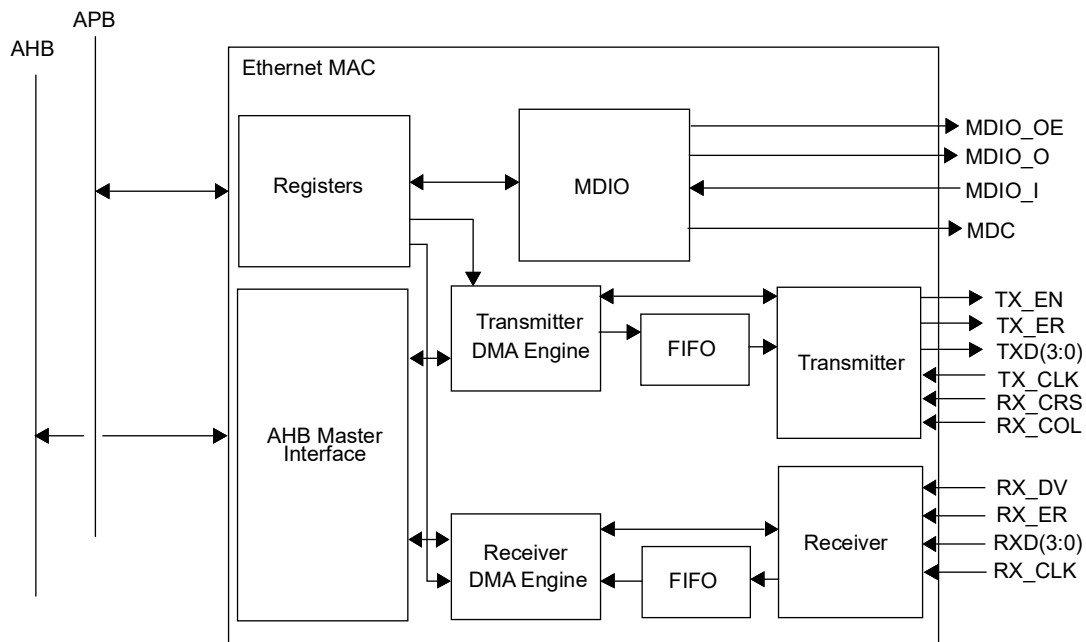


Figure 49. Block diagram of the internal structure of the GRETH.

## 25.2 Operation

### 25.2.1 System overview

The GRETH consists of 3 functional units: The DMA channels, MDIO interface.

The main functionality consists of the DMA channels which are used to transfer data between an AHB bus and an Ethernet network. There is one transmitter DMA channel and one Receiver DMA channel. The operation of the DMA channels is controlled through registers accessible through the APB interface.

The MDIO interface is used for accessing configuration and status registers in one or more PHYs connected to the MAC. The operation of this interface is also controlled through the APB interface.

The Media Independent Interface (MII) is used for communicating with the PHY. There is an Ethernet transmitter which sends all data from the AHB domain on the Ethernet using the MII interface. Correspondingly, there is an Ethernet receiver which stores all data from the Ethernet on the AHB bus. Both of these interfaces use FIFOs when transferring the data streams.

### 25.2.2 Protocol support

The GRETH is implemented according to IEEE standard 802.3-2002 and IEEE standard 802.3Q-2003. There is no support for the optional control sublayer. This means that packets with type 0x8808 (the only currently defined ctrl packets) are discarded.

### 25.2.3 Clocking

GRETH has three clock domains: The AHB clock, Ethernet receiver clock and the Ethernet transmitter clock. The ethernet transmitter and receiver clocks are generated by the external ethernet PHY, and are inputs to the core through the MII interface. The three clock domains are unrelated to each other and all signals crossing the clock regions are fully synchronized inside the core.

Both full-duplex and half-duplex operating modes are supported and both can be run in either 10 or 100 Mbit. The minimum AHB clock for 10 Mbit operation is 2.5 MHz, while 18 MHz is needed for 100 Mbit. Using a lower AHB clock than specified will lead to excessive packet loss.

## 25.3 Tx DMA interface

The transmitter DMA interface is used for transmitting data on an Ethernet network. The transmission is done using descriptors located in memory.

### 25.3.1 Setting up a descriptor.

A single descriptor is shown in table 234 and 235. The number of bytes to be sent should be set in the length field and the address field should point to the data. The address must be word-aligned. If the interrupt enable (IE) bit is set, an interrupt will be generated when the packet has been sent (this requires that the transmitter interrupt bit in the control register is also set). The interrupt will be generated regardless of whether the packet was transmitted successfully or not. The Wrap (WR) bit is also a control bit that should be set before transmission and it will be explained later in this section.

Table 234. GRETH transmit descriptor word 0 (address offset 0x0)

31	16 15 14 13 12 11 10	0
RESERVED	AL   UE   IE   WR   EN	LENGTH
31: 16	RESERVED	
15	Attempt Limit Error (AL) - The packet was not transmitted because the maximum number of attempts was reached.	
14	Underrun Error (UE) - The packet was incorrectly transmitted due to a FIFO underrun error.	
13	Interrupt Enable (IE) - Enable Interrupts. An interrupt will be generated when the packet from this descriptor has been sent provided that the transmitter interrupt enable bit in the control register is set. The interrupt is generated regardless if the packet was transmitted successfully or if it terminated with an error.	
12	Wrap (WR) - Set to one to make the descriptor pointer wrap to zero after this descriptor has been used. If this bit is not set the pointer will increment by 8. The pointer automatically wraps to zero when the 1 kB boundary of the descriptor table is reached.	
11	Enable (EN) - Set to one to enable the descriptor. Should always be set last of all the descriptor fields.	
10: 0	LENGTH - The number of bytes to be transmitted.	

Table 235. GRETH transmit descriptor word 1 (address offset 0x4)

31	2 1 0
ADDRESS	RES
31: 2	Address (ADDRESS) - Pointer to the buffer area from where the packet data will be loaded.
1: 0	RESERVED

To enable a descriptor the enable (EN) bit should be set and after this is done, the descriptor should not be touched until the enable bit has been cleared by the GRETH.

### 25.3.2 Starting transmissions

Enabling a descriptor is not enough to start a transmission. A pointer to the memory area holding the descriptors must first be set in the GRETH. This is done in the transmitter descriptor pointer register. The address must be aligned to a 1 kB boundary. Bits 31 to 10 hold the base address of descriptor area while bits 9 to 3 form a pointer to an individual descriptor. The first descriptor should be located at the base address and when it has been used by the GRETH the pointer field is incremented by 8 to point at the next descriptor. The pointer will automatically wrap back to zero when the next 1 kB boundary has been reached (the descriptor at address offset 0x3F8 has been used). The WR bit in the descriptors can be set to make the pointer wrap back to zero before the 1 kB boundary.

# LEON3FT Microcontroller

The pointer field has also been made writable for maximum flexibility but care should be taken when writing to the descriptor pointer register. It should never be touched when a transmission is active.

The final step to activate the transmission is to set the transmit enable bit in the control register. This tells the GRETH that there are more active descriptors in the descriptor table. This bit should always be set when new descriptors are enabled, even if transmissions are already active. The descriptors must always be enabled before the transmit enable bit is set.

### 25.3.3 Descriptor handling after transmission

When a transmission of a packet has finished, status is written to the first word in the corresponding descriptor. The Underrun Error bit is set if the FIFO became empty before the packet was completely transmitted while the Attempt Limit Error bit is set if more collisions occurred than allowed. The packet was successfully transmitted only if both of these bits are zero. The other bits in the first descriptor word are set to zero after transmission while the second word is left untouched.

The enable bit should be used as the indicator when a descriptor can be used again, which is when it has been cleared by the GRETH. There are three bits in the GRETH status register that hold transmission status. The Transmitter Error (TE) bit is set each time an transmission ended with an error (when at least one of the two status bits in the transmit descriptor has been set). The Transmitter Interrupt (TI) is set each time a transmission ended successfully.

The transmitter AHB error (TA) bit is set when an AHB error was encountered either when reading a descriptor or when reading packet data. Any active transmissions were aborted and the transmitter was disabled. The transmitter can be activated again by setting the transmit enable register.

### 25.3.4 Setting up the data for transmission

The data to be transmitted should be placed beginning at the address pointed by the descriptor address field. The GRETH does not add the Ethernet address and type fields so they must also be stored in the data buffer. The 4 B Ethernet CRC is automatically appended at the end of each packet. Each descriptor will be sent as a single Ethernet packet.

## 25.4 Rx DMA interface

The receiver DMA interface is used for receiving data from an Ethernet network. The reception is done using descriptors located in memory.

### 25.4.1 Setting up descriptors

A single descriptor is shown in table 236 and 237. The address field should point to a word-aligned buffer where the received data should be stored. If the interrupt enable (IE) bit is set, an interrupt will be generated when a packet has been received to this buffer (this requires that the receiver interrupt bit in the control register is also set). The interrupt will be generated regardless of whether the packet was received successfully or not. The Wrap (WR) bit is also a control bit that should be set before the descriptor is enabled and it will be explained later in this section.

Table 236. GRETH receive descriptor word 0 (address offset 0x0)

31	27	26	25	19	18	17	16	15	14	13	12	11	10	0
RESERVED		MC	RESERVED			LE	OE	CE	FT	AE	IE	WR	EN	LENGTH

31: 27 RESERVED

26 Multicast address (MC) - The destination address of the packet was a multicast address (not broadcast).

25: 19 RESERVED

18 Length error (LE) - The length/type field of the packet did not match the actual number of received bytes.



# LEON3FT Microcontroller

Table 236. GRETH receive descriptor word 0 (address offset 0x0)

17	Overrun error (OE) - The frame was incorrectly received due to a FIFO overrun.
16	CRC error (CE) - A CRC error was detected in this frame.
15	Frame too long (FT) - A frame larger than the maximum size was received. The excessive part was truncated.
14	Alignment error (AE) - An odd number of nibbles were received.
13	Interrupt Enable (IE) - Enable Interrupts. An interrupt will be generated when a packet has been received to this descriptor provided that the receiver interrupt enable bit in the control register is set. The interrupt is generated regardless if the packet was received successfully or if it terminated with an error.
12	Wrap (WR) - Set to one to make the descriptor pointer wrap to zero after this descriptor has been used. If this bit is not set the pointer will increment by 8. The pointer automatically wraps to zero when the 1 kB boundary of the descriptor table is reached.
11	Enable (EN) - Set to one to enable the descriptor. Should always be set last of all the descriptor fields.
10: 0	LENGTH - The number of bytes received to this descriptor.

Table 237. GRETH receive descriptor word 1 (address offset 0x4)

31	ADDRESS	2	1	0
				RES

31: 2	Address (ADDRESS) - Pointer to the buffer area from where the packet data will be loaded.
1: 0	RESERVED

## 25.4.2 Starting reception

Enabling a descriptor is not enough to start reception. A pointer to the memory area holding the descriptors must first be set in the GRETH. This is done in the receiver descriptor pointer register. The address must be aligned to a 1 kB boundary. Bits 31 to 10 hold the base address of descriptor area while bits 9 to 3 form a pointer to an individual descriptor. The first descriptor should be located at the base address and when it has been used by the GRETH the pointer field is incremented by 8 to point at the next descriptor. The pointer will automatically wrap back to zero when the next 1 kB boundary has been reached (the descriptor at address offset 0x3F8 has been used). The WR bit in the descriptors can be set to make the pointer wrap back to zero before the 1 kB boundary.

The pointer field has also been made writable for maximum flexibility but care should be taken when writing to the descriptor pointer register. It should never be touched when reception is active.

The final step to activate reception is to set the receiver enable bit in the control register. This will make the GRETH read the first descriptor and wait for an incoming packet.

## 25.4.3 Descriptor handling after reception

The GRETH indicates a completed reception by clearing the descriptor enable bit. The other control bits (WR, IE) are also cleared. The number of received bytes is shown in the length field. The parts of the Ethernet frame stored are the destination address, source address, type and data fields. Bits 17-14 in the first descriptor word are status bits indicating different receive errors. All four bits are zero after a reception without errors. The status bits are described in table 236.

Packets arriving that are smaller than the minimum Ethernet size of 64 B are not considered as a reception and are discarded. The current receive descriptor will be left untouched and used for the first packet arriving with an accepted size. The TS bit in the status register is set each time this event occurs.

If a packet is received with an address not accepted by the MAC, the IA status register bit will be set.

Packets larger than maximum size cause the FT bit in the receive descriptor to be set. The length field is not guaranteed to hold the correct value of received bytes. The counting stops after the word containing the last byte up to the maximum size limit has been written to memory.

# LEON3FT Microcontroller

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The address word of the descriptor is never touched by the GRETH.

## 25.4.4 Reception with AHB errors

If an AHB error occurs during a descriptor read or data store, the Receiver AHB Error (RA) bit in the status register will be set and the receiver is disabled. The current reception is aborted. The receiver can be enabled again by setting the Receive Enable bit in the control register.

## 25.5 MDIO Interface

The MDIO interface provides access to PHY configuration and status registers through a two-wire interface which is included in the MII interface. The GRETH provided full support for the MDIO interface.

The MDIO interface can be used to access from 1 to 32 PHY containing 1 to 32 16-bit registers. A read transfer is set up by writing the PHY and register addresses to the MDIO Control register and setting the read bit. This caused the Busy bit to be set and the operation is finished when the Busy bit is cleared. If the operation was successful the Linkfail bit is zero and the data field contains the read data. An unsuccessful operation is indicated by the Linkfail bit being set. The data field is undefined in this case.

A write operation is started by writing the 16-bit data, PHY address and register address to the MDIO Control register and setting the write bit. The operation is finished when the busy bit is cleared and it was successful if the Linkfail bit is zero.

### 25.5.1 PHY interrupts

The core also supports status change interrupts from the PHY. A level sensitive interrupt signal can be connected on the mdint input. The PHY status change bit in the status register is set each time an event is detected in this signal. If the PHY status interrupt enable bit is set at the time of the event the core will also generate an interrupt on the AHB bus.

## 25.6 Media Independent Interfaces

There are several interfaces defined between the MAC sublayer and the Physical layer. The GRETH supports two of them: The Media Independent Interface (MII).

The MII was defined in the 802.3 standard and is most commonly supported. The ethernet interface have been implemented according to this specification. It uses 16 signals.

To support lower speed where the operation and clock frequency of the core and phy remains unchanged i.e. running at 10Mb/s when the controller is configured for 100Mb/s speed enable signals should be created to mimic the desired bit rate.

When operating at 10Mb/s, every byte of the MAC frame is repeated 10 clock periods to achieve the correct bit rate. The core does not take care of this operation and enable signals with toggling frequency of the correct bit rate needs to be created.

# LEON3FT Microcontroller

## 25.7 Registers

The core is programmed through registers mapped into APB address space.

Table 238. GRETH registers

APB address offset	Register
0x0	Control register
0x4	Status/Interrupt-source register
0x8	MAC Address MSB
0xC	MAC Address LSB
0x10	MDIO Control/Status
0x14	Transmit descriptor pointer
0x18	Receiver descriptor pointer
0x1C	Not Used
0x20	Not used
0x24	Not used

# LEON3FT Microcontroller

## 25.7.1 Control Register

Table 239.0x00 - CTRL - GRETH control register

31		30		27		26		25		24		15		14		13		12		11		10		9		8		7		6		5		4		3		2		1		0	
EA	RESERVED	MA	MC	RESERVED								PI	RES	RS	PM	FD	RI	TI	RE	TE																							
0	0	1	0	0								0	0	0	0	0	0	0	0	0	0																						
r	r	r	r	r								rw	r	wc	rw	rw	rw	rw	rw	rw	rw																						

- 31 EDCL available (A) - Set to 0 to indicate that the core does not implement EDCL. Read only.
- 30: 27 RESERVED
- 27 RESERVED
- 26 MDIO interrupts available (MA) - Set to one to indicate that the core supports MDIO interrupts. Read only.
- 25 Multicast available (MC) - Set to zero to indicate that the core does not support multicast address reception. Read only.
- 24: 11 RESERVED
- 10 PHY status change interrupt enable (PI) - Enables interrupts for detected PHY status changes.
- 9: 7 RESERVED
- 6 Reset (RS) - A one written to this bit resets the GRETH core. Self clearing. No other accesses should be done .to the slave interface other than polling this bit until it is cleared.
- 5 Promiscuous mode (PM) - If set, the GRETH operates in promiscuous mode which means it will receive all packets regardless of the destination address. Reset value: '0'.
- 4 Full duplex (FD) - If set, the GRETH operates in full-duplex mode otherwise it operates in half-duplex. Reset value: '0'.
- 3 Receiver interrupt (RI) - Enable Receiver Interrupts. An interrupt will be generated each time a packet is received when this bit is set. The interrupt is generated regardless if the packet was received successfully or if it terminated with an error. Reset value: '0'.
- 2 Transmitter interrupt (TI) - Enable Transmitter Interrupts. An interrupt will be generated each time a packet is transmitted when this bit is set. The interrupt is generated regardless if the packet was transmitted successfully or if it terminated with an error. Reset value: '0'.
- 1 Receive enable (RE) - Should be written with a one each time new descriptors are enabled. As long as this bit is one the GRETH will read new descriptors and as soon as it encounters a disabled descriptor it will stop until RE is set again. This bit should be written with a one after the new descriptors have been enabled. Reset value: '0'.
- 0 Transmit enable (TE) - Should be written with a one each time new descriptors are enabled. As long as this bit is one the GRETH will read new descriptors and as soon as it encounters a disabled descriptor it will stop until TE is set again. This bit should be written with a one after the new descriptors have been enabled. Reset value: '0'.

# LEON3FT Microcontroller

## 25.7.2 Status Register

Table 240.0x04 - STAT - GRETH status register

31	9	8	7	6	5	4	3	2	1	0	
RESERVED			PS	IA	TS	TA	RA	TI	RI	TE	RE
			0	0	0	NR	NR	NR	NR	NR	NR
			wc	wc	wc	wc	wc	wc	wc	wc	wc

- 8            PHY status changes (PS) - Set each time a PHY status change is detected.
- 7            Invalid address (IA) - A packet with an address not accepted by the MAC was received. Cleared when written with a one. Reset value: '0'.
- 6            Too small (TS) - A packet smaller than the minimum size was received. Cleared when written with a one. Reset value: '0'.
- 5            Transmitter AHB error (TA) - An AHB error was encountered in transmitter DMA engine. Cleared when written with a one. Not Reset.
- 4            Receiver AHB error (RA) - An AHB error was encountered in receiver DMA engine. Cleared when written with a one. Not Reset.
- 3            Transmitter interrupt (TI) - A packet was transmitted without errors. Cleared when written with a one. Not Reset.
- 2            Receiver interrupt (RI) - A packet was received without errors. Cleared when written with a one. Not Reset.
- 1            Transmitter error (TE) - A packet was transmitted which terminated with an error. Cleared when written with a one. Not Reset.
- 0            Receiver error (RE) - A packet has been received which terminated with an error. Cleared when written with a one. Not Reset.

## 25.7.3 MAC Address MSB

Table 241.0x08 - MACMSB - GRETH MAC address MSB.

31	16	15	0
RESERVED		Bit 47 downto 32 of the MAC address	
		NR	
		rw	

- 31: 16        RESERVED
- 15: 0        The two most significant bytes of the MAC Address. Not Reset.

## 25.7.4 MAC Address LSB

Table 242.0x0C - MACLSB - GRETH MAC address LSB.

31	0
Bit 31 downto 0 of the MAC address	

- 31: 0        The four least significant bytes of the MAC Address. Not Reset.

# LEON3FT Microcontroller

## 25.7.5 MDIO ctrl/status Register

Table 243.0x10 - MDIO - GRETH MDIO ctrl/status register.

31	16	15	11	10	6	5	4	3	2	1	0
DATA			PHYADDR		REGADDR		RES	BU	LF	RD	WR
0			*		0			0	1	0	0
rw			rw		rw			r	r	rw	rw

- 31: 16 Data (DATA) - Contains data read during a read operation and data that is transmitted is taken from this field. Reset value: 0x0000.
- 15: 11 PHY address (PHYADDR) - This field contains the address of the PHY that should be accessed during a write or read operation. Reset value: "00000".
- 10: 6 Register address (REGADDR) - This field contains the address of the register that should be accessed during a write or read operation. Reset value: "00000".
- 5:4 RESERVED
- 3 Busy (BU) - When an operation is performed this bit is set to one. As soon as the operation is finished and the management link is idle this bit is cleared. Reset value: '0'.
- 2 Linkfail (LF) - When an operation completes (BUSY = 0) this bit is set if a functional management link was not detected. Reset value: '1'.
- 1 Read (RD) - Start a read operation on the management interface. Data is stored in the data field. Reset value: '0'.
- 0 Write (WR) - Start a write operation on the management interface. Data is taken from the Data field. Reset value: '0'.

## 25.7.6 Transmitter Descriptor Table Base Address Register

Table 244.0x14 - TXBASE - GRETH transmitter descriptor table base address register.

31	10	9	3	2	0
BASEADDR			DESCPNT		RES
NR			0		0
rw			rw		r

- 31: 10 Transmitter descriptor table base address (BASEADDR) - Base address to the transmitter descriptor table. Not Reset.
- 9: 3 Descriptor pointer (DESCPNT) - Pointer to individual descriptors. Automatically incremented by the Ethernet MAC.
- 2: 0 RESERVED

## 25.7.7 Receiver Descriptor Table Base Address Register

Table 245.0x18 - RXBASE - GRETH receiver descriptor table base address register.

31	10	9	3	2	0
BASEADDR			DESCPNT		RES
NR			0		0
rw			rw		r

- 31: 10 Receiver descriptor table base address (BASEADDR) - Base address to the receiver descriptor table. Not Reset.
- 9: 3 Descriptor pointer (DESCPNT) - Pointer to individual descriptors. Automatically incremented by the Ethernet MAC.
- 2: 0 RESERVED

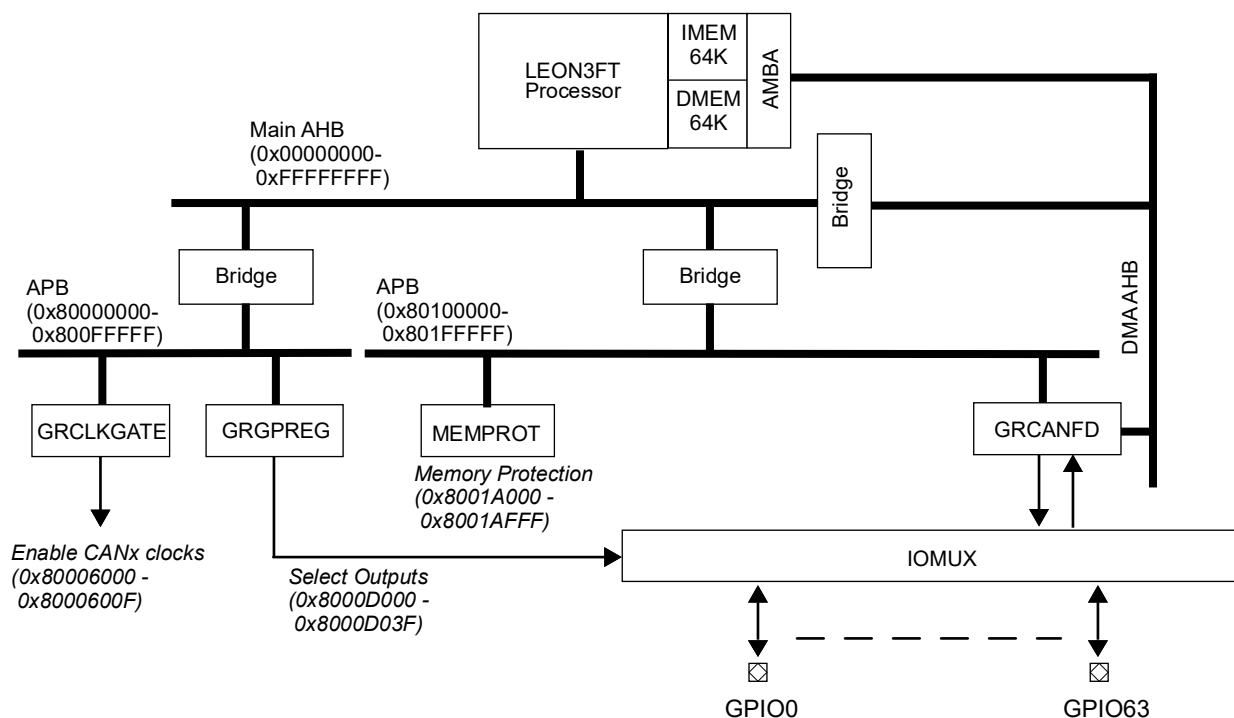
# LEON3FT Microcontroller

## 26 CAN Flexible Data-Rate Controller with CANOpen support

The GR716B microcontroller comprise a CAN-FD controller (GRCANFD) units.

The CAN-FD controller (GRCANFD) units are located on APB bus in the address range from 0x80102000 to 0x80102FFF . See GRCANFD units connections in the next drawing. The drawing picture memory locations and functions used for GRCANFD configuration and control.

Figure 50. GR716B GRCANFD bus and pin connection



The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable individual GRCANFD units. The unit **GRCLKGATE** can also be used to perform reset of individual GRCANFD units. Software must enable clock and release reset described in section 27 before GRCANFD configuration and transmission can start.

External IO selection per GRCANFD unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

Each **GRACNFDx** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. Configuration and status registers are described in section 26.11.

System can be configured to protect and restrict access to individual GRCANFD units in the **MEMPROT** unit. See section 47 for more information.

### 26.1 Overview

GRCANFD implements a CAN-FD controller with a top DMA layer handling the configuration of the controller and the communication between the internal CAN-FD controller and a memory external to the IP.

The internal codec is the CAN-FD controller implementing the MAC and PL sub-layers of the protocol: transmission and reception of frames, error detection and signaling, frame acknowledgment, bit resynchronization, etc. This functionality is compliant with the ISO standard 11898-1:2015 (2nd edition).

## LEON3FT Microcontroller

Additionally, GRCANFD implements the CANOpen Minimal Set Protocol as per the ECSS-E-ST-50-15C specification, section 9. The controller acts as a slave node (i.e. cannot operate as a CANOpen master). This functionality allows an external CAN node to access the AMBA address space of the device by means of CANOpen PDOs, similarly to RMAP in SpaceWire. The functionality can be configured upon start-up to enable automatic operation in simple applications without need of software intervention. The user can switch between the standard and the CANOpen mode in run-time via the APB interface.

The following block diagram depicts the main components of GRCANFD.

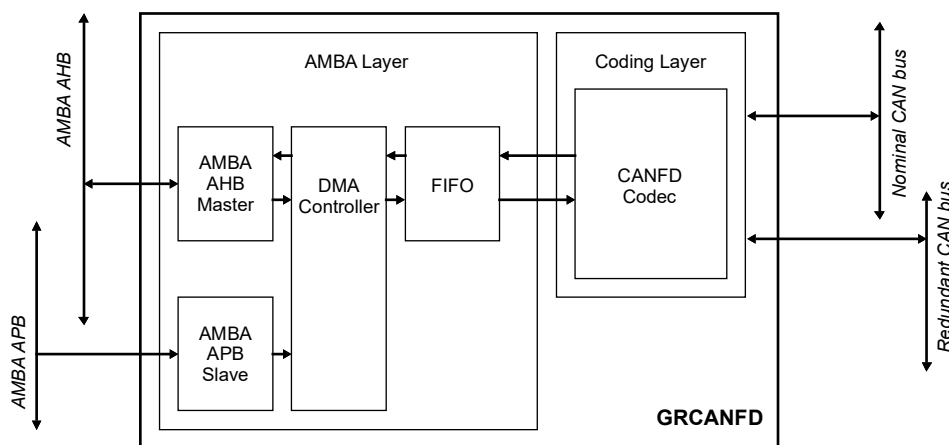


Figure 51. Block diagram

The top AMBA layer contains the memory-mapped registers for the configuration of the IP, accessible through the APB interface. It also controls the global functionality of the controller by fetching frames to be transmitted from the external memory (TX channel) and by storing received frames into the external memory (RX channel) in standard mode, and by processing any input CANOpen commands and providing the reply when applicable in CANOpen mode.

This layer also includes 2 internal SRAMs for the transmit and receive channels. These buffers are used to store the data bytes of a frame, whereas the control bits are stored in registers. The size of each buffer is 64 to 512. Note that these buffers are only used in standard mode, no additional memory is required in CANOpen mode.

The external memory where the frames are stored in standard mode is commonly referred to as the circular buffers, and it may be located on-chip or external to the chip. The controller will write and read from this memory through the master interface. There is a separate buffer for the TX and for the RX channels. Although the default topology is circular, straight buffers are also supported. The content of the circular buffers is handled by pointers.

In standard mode, the frames are temporarily buffered in the internal SRAMs. For transmission, the DMA engine fetches frames from the TX circular buffer and the CAN-FD codec transmits them as soon as the SRAM contains a full frame. Likewise, frames received by the codec are temporarily stored in the internal SRAM, and written to the RX circular buffer as soon as the reception is complete. The communication with the circular buffer takes place via the bus master interface.

In CANOpen mode, GRCANFD receives and acknowledges any incoming frame according to the ISO standard, regardless of its format. The frame is then decoded to identify if it is a PDO, SYNC or Heartbeat command, otherwise it is discarded. The CANOpen master node can therefore issue read and write commands, as well as to trigger interrupts in the slave via the CAN interface.

The controller may have up to 3 separate interrupt lines. The first one is the common line, which comprises interrupts for reception and transmission of frames, update on the status of the controller and events on the CAN bus. The other two interrupt lines are used for SYNC messages (for TX and RX channel, respectively) in standard mode. All interrupts are maskable by accessing the APB registers.



# LEON3FT Microcontroller

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GRCANFD implements bus redundancy: its interface includes two RX and two TX lines. The pair of lines to be used can be selected via the AMBA APB interface. The transmission and reception of frames can only occur on one bus at a time. An additional signal is included to enable or disable the output of the external CAN-FD transceiver.

## 26.1.1 Function

The core implements the following functions:

- CAN-FD core functionality
- TX channel: frame fetching, buffering and transmission
- RX channel: frame reception, filtering, buffering and storage
- CANOpen interpreter supporting PDOs 1-4, SYNC and Heartbeat commands
- SYNC message detection for both TX and RX channels
- Status and monitoring of the IP
- Interrupt generation
- Redundancy selection

## 26.2 CAN Interface

The external interface towards the CAN bus features two redundant pairs of transmit output and receive input (i.e. 0 and 1).

The active pair (i.e. 0 or 1) is selectable by means of a configuration register bit. Note that all reception and transmission is made over the active pair.

For each pair, there is one enable output (i.e. 0 and 1), each being individually programmable. The enable outputs can be used for enabling an external physical driver. Note that both pairs can be enabled simultaneously. The polarity for the enable/inhibit inputs on physical interface drivers may differ, thus the meaning of the enable output is undefined.

Redundancy is implemented by means of Selective Bus Access. Note that the active pair selection above provides means to meet this requirement.

## 26.3 Protocol compliance

The CAN-FD controller included in GRCANFD compliant with the ISO standard for CAN with the FD extension: ISO 11898-1:2015 (2nd edition). The minimal CANOpen implementation is compatible with the ECSS-E-ST-50-15C specification.

## 26.4 Status and monitoring

The GRCANFD register interface provides status and monitoring data, including:

- Operational mode (standard or CANOpen)
- Ongoing transmission
- Bus-off state
- Error-passive mode
- Overrun during reception
- Transmitter error counter (8 bits)
- Receiver error counter (8 bits)

# LEON3FT Microcontroller

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Some of the previous indicators are also written to the circular buffer every time a frame is received and stored in standard mode. This is described later in 26.5.2. Note that this only applies to the RX channel.

## 26.5 CAN and CAN-FD frames

### 26.5.1 Frame formats

As defined in the CAN-FD standard, GRCANFD supports the following formats for the transmission and reception of data frames:

- Classical Base Frame Format (CBFF)
- Classical Extended Frame Format (CEFF)
- FD Base Frame Format (FBFF)
- FD Extended Frame Format (FEFF)

Remote frames are compatible with the classical CAN formats (CBFF and CEFF), but not with the new FD formats (FBFF and FEFF), as per the standard. Error Frames (EF) and Overload Frames (OL) are fully supported too.

The following parameters define the format of a frame. A brief description and additional considerations when working with the controller are included. For a complete overview on the formats and their corresponding fields, please refer to the ISO standard for CAN-FD.

- **ID:** identifier of the frame. It consists of two parts: the base ID (11 bits) and the extended ID (18 bits, optional). Frames with Base format (CBFF and FBFF) only use the base ID, whereas frames with Extended format (CEFF and FEFF) use both.
- **IDE:** this parameter selects between Base (0b) and Extended Format (1b). It determines if the extended ID shall be appended to the base ID when building a frame, as described above. This parameter does not depend on whether it is an FD frame or not, so the value of other bits such as FDF or BRS is irrelevant.
- **RTR:** this parameter selects between Data (0b) and Remote frames (1b). Remote frames are only compatible with classical CAN frames. This means that it must be avoided to set both RTR and FDF to 1b when describing a frame, as the behavior is undefined.
- **FDF:** this parameter determines if the frame has classical (0b: CBFF and CEFF) or FD format (1b: FBFF and FEFF). The FD format allows to transmit larger payloads of up to 64 bytes, and features a more robust CRC algorithm: CRC-17 or CRC-21, depending on the data length. Optionally, it also enables the possibility of switching to a higher bit-rate. This depends on the configuration of the BRS bit, as described below. When setting FDF to 1b, no Remote frames shall be requested (i.e. RTR should be set to 0b).
- **BRS:** this bit determines whether the bit-rate shall be switched for the data phase of a frame. It is only meaningful for FD frames (FDF set to 1b). Therefore, the bit is ignored for classical CAN frames (FDF to 0b).
- **DLC:** it selects the data length of the frame. Its encoding varies depending on whether FD format is used or not. For classical frames, the maximum payload is 8 bytes, whereas FD formats may contain up to 64 bytes of data.

It is important to remark that it is optional to enable the BRS bit for FD frames. FD frames with no bit-rate switching still present the advantage of enabling larger data payloads than in classical CAN frames with more robust CRC algorithms, although the full frame would be transmitted at a constant, nominal bit-rate.

# LEON3FT Microcontroller

## 26.5.2 Frame memory mapping (standard mode only)

A descriptor is the minimum unit used to represent a frame. It consists of four 32-bit words. The number of descriptors needed to represent a frame varies from 1 to 5. For classical CAN frames (CBFF and CEFF formats) only one descriptor is needed. For CAN-FD frames (FBFF and FEFF formats) the number of descriptors depends on the data length of the frame: whereas frames with up to 8 bytes only require 1 descriptor, as with classical CAN frames, frames with 64 bytes of data payload require 5 descriptors.

The first descriptor in a frame always includes the control bits describing the frame, as well as information regarding the status of the bus and the IP. This is applicable to both classical CAN and CAN-FD frames. If a frame requires more than one descriptor, the successive descriptors (from 2 up to 5) do not replicate the control and status bits, but only include data bytes. Therefore, each of these descriptors may contain up to 16 bytes of data. Descriptors belonging to the same frame shall always appear consecutively in the circular buffer, taking into account wrap-around conditions.

Each CAN descriptor is aligned to 4 words address boundaries, i.e. the 4 least significant byte address bits are zero for the first word in a CAN descriptor. Note that this frame representation and memory mapping is backwards compatible with GRCAN, which only supports classical CAN format.

Table 246 describes the memory mapping for the first descriptor of a frame, including both control and status bits (first half of the descriptor) and data bytes (second half).

Table 246. CAN message representation in memory.

AHB addr		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
0x0		IDE	RT R	-	bID											eID				
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
		eID																		
0x4		DLC				-	FD F	BR S	-	TxErrCtr										
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
		RxErrCtr							-	-	-	-	BM Err	OR	Off	Pass				
0x8		Byte 0 (first transmitted)								Byte 1										
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
		Byte 2								Byte 3										
0xC		Byte 4								Byte 5										
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
		Byte 6								Byte 7										

Values: Levels according to CAN standard: 1b is recessive, 0b is dominant

Legend: Naming and numbering according to CAN standard

IDE Identifier Extension: 1b for Extended Format (Base + Extended ID), 0b for Standard Format (Base ID)

RTR Remote Transmission Request: 1b for Remote Frame (only classical CAN), 0b for Data Frame

# LEON3FT Microcontroller

bID	Base Identifier		
eID	Extended Identifier		
DLC	Data Length Code, according to CAN standard:		
		0000b	0 bytes
		0001b	1 byte
		0010b	2 bytes
		0011b	3 bytes
		0100b	4 bytes
		0101b	5 bytes
		0110b	6 bytes
		0111b	7 bytes
		1000b	8 bytes
		1001b	12 bytes (only CAN-FD)
		1010b	16 bytes (only CAN-FD)
		1011b	20 bytes (only CAN-FD)
		1100b	24 bytes (only CAN-FD)
		1101b	32 bytes (only CAN-FD)
		1110b	48 bytes (only CAN-FD)
		1111b	64 bytes (only CAN-FD)
FDF	Flexible-Data Rate Frame	1b for FD Format, 0b for Classic Format	
BRS	Switch Data Bit Rate	1b for bit-rate switch (only CAN-FD frames), 0b for constant bit-rate	
TxErxCntr	Transmission Error Counter		
RxErxCntr	Reception Error Counter		
BMErr	Bus Master Error during previous accesses to the bus when 1b		
OR	Reception Overrun when 1b		
OFF	Bus-Off mode when 1b		
PASS	Error-Passive mode when 1b		
Byte 00 to 07 Transmit/Receive data, Byte 00 first Byte 07 last			

Status bits (TxErrCntr, RxErrCntr, BMErr, OR, OFF, PASS) only apply to the RX channel. The controller will write these bits to the circular buffer together with the received frame. For transmission, these bits are not used, therefore they can be simply set to 0b when setting up a frame.

Frames with DLC > 1000b will only result in more than 8 bytes of data for FD frames (FDF set to 1b). For classical CAN frames, the maximum data size is limited to 8 bytes, even if DLC is higher than 1000b. Note also that GRCANFD will ignore the BRS bit if FDF is set to 0b (classical CAN format), so that the Nominal Bit Rate would be used for the entire frame.

If an FD frame contains more than 8 data bytes, it requires additional descriptors to be fully represented in the circular buffer. These descriptors only contain data bytes, and its memory representation is the continuation of the second half of the first descriptor:

- Descriptor #2: data bytes 8 to 23.
- Descriptor #3: data bytes 24 to 39.
- Descriptor #4: data bytes 40 to 55.
- Descriptor #5: data bytes 56 to 63 (second half of the descriptor is unused).

For more information regarding the format of the frame and the content of a descriptor, please refer to 26.5.1 and the CAN-FD ISO standard.

## 26.6 Operational modes

GRCANFD supports two modes of operation: standard and CANOpen. In standard mode, the controller splits the frame in descriptors, as explained in 26.5.2, and the transmission and reception is controlled by hardware pointers handling the TX and RX circular buffers. In CANOpen mode the

# LEON3FT Microcontroller

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controller becomes a CANOpen interpreter, decoding any incoming frame and reacting accordingly. This mode interacts with neither the circular buffers nor the internal SRAM memories.

The operational mode shall be selected, i.e. GRCANFD cannot operate in standard mode and CANOpen mode simultaneously. This section describes how to set the default mode after reset and how to switch between modes.

Note that the operational mode only affects the top DMA layer of the IP. The internal CAN-FD controller shall handle all frames in any case, regardless of its format.

## 26.6.1 Default configuration

The interface is by default set to standard mode after reset expect for when remote access via CANOpen is enabled via bootstraps. In remote CANOpen mode CAN timing parameters needs to be configured so that communication can be established automatically without software intervention. The parameters that can be configured are:

- Internal CAN-FD controller enable.
- Active CAN bus selection and transceivers output enable.
- CAN bit time parameters (only for classical bit-rate).
- CANOpen mode enable.
- CANOpen node ID.

For more information about CANOpen bootstrap configuration see section 3.1.

## 26.6.2 Switching between standard and CANOpen mode

In order to switch between standard and CANOpen mode, several conditions shall be met before the controller can effectively switch to the requested mode. This prevents the controller from entering any unexpected state if the mode is switched during an ongoing operation.

To switch from standard to CANOpen mode, the following conditions shall be met:

- CANOpen mode enabled: set the Enable bit in the CANOpen Control Register to 1b.
- Transmitter disabled: set the Enable bit in the Transmit Channel Control Register to 0b.
- Receiver disabled: set the Enable bit in the Receive Channel Control Register to 0b.

Any ongoing operation shall finalize (i.e. all FSMs related to the TX and RX channels shall be in idle state) before the request to change to CANOpen mode is granted.

To switch from CANOpen to standard mode, the following conditions shall be met:

- CANOpen mode disabled: set the Enable bit in the CANOpen Control Register to 0b.

Any ongoing operation shall finalize (i.e. the CANOpen FSM shall be in idle state) before the request to change to standard mode is granted.

The status of the controller can be monitored at any time by sampling the Mode bit in the Status Register.

## 26.7 Standard Mode - Transmission

The circular buffer for the transmit channel is defined by the following parameters:

- base address
- buffer size
- write pointer
- read pointer

The transmit channel can be enabled or disabled.

# LEON3FT Microcontroller

## 26.7.1 Circular buffer

### TBC: Determine the buffer type and size

The transmit channel operates on a circular buffer located in memory external to GRCANFD. The circular buffer can also be used as a straight buffer. The buffer memory is accessed via the bus master interface (such as AMBA AHB or AXI).

The size of the buffer is defined by the SIZE field in the Transmission Channel Size Register, specifying the number of CAN descriptors \* 4 that fit in the buffer.

E.g. CanTxSIZE.SIZE =2 means 8 CAN descriptors fit in the buffer.

Note however that it is not possible to fill the buffer completely, leaving at least one descriptor position in the buffer empty. This is to simplify wrap-around condition checking.

E.g. CanTxSIZE.SIZE =2 means that 7 CAN descriptors fit in the buffer at any given time.

## 26.7.2 Write and read pointers

The write pointer (WRITE field in the Transmission Channel Write Register) indicates the position +1 of the last CAN descriptor written to the buffer. The write pointer operates on number of CAN descriptors, not on absolute or relative addresses.

The read pointer (READ field in the Transmission Channel Read Register) indicates the position +1 of the last CAN descriptor read from the buffer. The read pointer operates on number of CAN descriptors, not on absolute or relative addresses.

The difference between the write and the read pointers is the number of CAN descriptors available in the buffer for transmission. The difference is calculated using the buffer size, specified by the CanTxSIZE.SIZE field, taking wrap around effects of the circular buffer into account.

Examples:

- There are 2 CAN descriptors available for transmit when CanTxSIZE.SIZE=2, CanTxWR.WRITE=2 and CanTxRD.READ=0.
- There are 2 CAN descriptors available for transmit when CanTxSIZE.SIZE=2, CanTxWR.WRITE =0 and CanTxRD.READ =6.
- There are 2 CAN descriptors available for transmit when CanTxSIZE.SIZE=2, CanTxWR.WRITE =1 and CanTxRD.READ =7.
- There are 2 CAN descriptors available for transmit when CanTxSIZE.SIZE=2, CanTxWR.WRITE =5 and CanTxRD.READ =3.

When a frame has been successfully transmitted, the read pointer (CanTxRD.READ) is automatically updated, taking wrap-around effects of the circular buffer into account. If a frame consists of more than one descriptor, the pointer is not incremented one by one, but it is updated to the next descriptor to be read from the buffer.

Whenever the write pointer CanTxWR.WRITE and read pointer CanTxRD.READ are equal, there are no CAN descriptors available for transmission.

## 26.7.3 Location

The location of the circular buffer is defined by a base address in Transmission Channel Address Register, which is an absolute address. The location of a circular buffer is aligned on a 1kbyte address boundary.

## 26.7.4 Transmission procedure

When the channel is enabled (ENABLE bit in the Transmission Channel Control Register equal to 1b), as soon as there is a difference between the write and read pointer, GRCANFD will start fetching

the first descriptor of a frame, whose position is indicated by the read pointer. If a frame consists of more than one descriptor, GRCANFD will continue fetching them until the full frame has been read. GRCANFD will decode the DLC field, available in the first descriptor, in order to know how many descriptors shall be fetched in total.

The one frame can be buffered by the core prior to transmission. The data bytes of a frame are stored in the internal TX SRAM, whereas the control bits are stored in registers. Note that the core will fetch one frame regardless of their data length. The core will stop fetching frames if there are no more frames initialized in the circular buffer.

Note that the TX channel should not be enabled if a potential difference between the write and read pointers could be created, to avoid the descriptor fetching to start prematurely. The TX write pointer shall not be updated until all the descriptors forming the frame are ready to be fetched from the circular buffer.

The read pointer (CanTxRD.READ) is automatically updated after a successful transmission, taking into account wrap around effects of the circular buffer. The content of the local SRAM may then be overwritten, so a new frame would be fetched as soon as the write and read pointers differ.

If the single-shot mode is enabled for the TX channel (CanTxCTRL.SINGLE=1), any frame for which the arbitration is lost, or failed for some other reason such as ACK missing, will lead to the TX channel being automatically disabled (CanTxCTRL.ENABLE=0). The frame will not be put up for re-arbitration and the local SRAM will be emptied, in order not to block future transmissions.

Interrupts are provided to aid the user during transmission, as described in detail later in this section. The main interrupts are the Tx, TxEmpty and TxIrq which are issued respectively after the successful transmission of a frame, when all frames in the circular buffer have been transmitted and when a pre-defined number of descriptors have been transmitted. The TxLoss interrupt is asserted whenever a transmission does not complete: examples of this are loss of arbitration or communication errors. The TxSync interrupt is issued when a frame matching the SYNC pattern is successfully transmitted. Additional interrupts are provided to signal error conditions on the CAN bus and the AMBA bus.

### 26.7.5 AMBA error

An error response occurring on the AMBA bus while a frame descriptor is being fetched will result in a BmRdErr interrupt. Consequently the bit BMErr of the Status Register is set to 1b, and can only be cleared by reading that register.

If the CanCONF.ABORT bit is set to 0b, GRCANFD will automatically try to fetch the same frame descriptor again.

If the CanCONF.ABORT bit is set to 1b, the TX channel will be disabled (ENABLE bit in the Transmission Channel Control register is cleared automatically to 0b). The read pointer can be used to determine which frame caused the bus master error (but not the specific descriptor, if the frame contains more than one). If the error occurs while the other frame in the local SRAM is being transmitted, the transmission is not interrupted, in order not to disrupt the CAN bus. If the transmission is acknowledged, the pointers are updated accordingly, even if the channel is already disabled.

### 26.7.6 Enable and disable

When the TX channel is disabled (ENABLE bit in the Transmission Channel Control Register cleared to 0b) during an ongoing transmission, the internal CAN-FD codec will not abort the transmission, but attempt to finish it until the frame is acknowledged, the arbitration is lost or any error is detected. If the frame is sent successfully, the read pointer (CanTxRD.READ) is automatically incremented. Any associated interrupt will be generated.

The progress of any ongoing access can be observed via the ONGOING bit in the Transmission Channel Control Register. The ONGOING bit must be 0b before the channel can be re-configured safely (i.e. changing address, size or read pointer). It is also possible to monitor the Tx and TxLoss interrupts described hereafter.

# LEON3FT Microcontroller

GRCANFD includes a status bit in the TX channel control register called DisACK. This bit is used to indicate that the TX channel disable request has been acknowledged, and it will take effect as soon as the ongoing transmission finishes or fails to complete. The TX channel is not completely disabled until both ENABLE and DisACK are both 0b.

The channel can be re-enabled again without the need to re-configure the address, size and pointers.

Priority inversion is handled by disabling the transmitting channel, i.e. setting CanTxCTRL.ENABLE=0b as described above, and observing the progress, i.e. reading via the CanTxCTRL.ONGOING and CanTxCTRL.DisACK bits as described above. When the transmit channel is disabled, it can be re-configured and a higher priority frames can be transmitted. Note that the single shot mode does not require the channel to be disabled, but the progress should still be observed as above.

## 26.7.7 Interrupts

During transmission several interrupts can be generated:

- TxLoss: Frame transmission interrupted due to lost of arbitration, ACK not detected by the transmitter or errors during the transmission.
- TxErrCnt: Increment of the transmitter error counter.
- TxSync: Frame matching the SYNC filter transmitted.
- Tx: Successful transmission of a frame.
- TxEmpty: Successful transmission of all the frames in the circular buffer.
- TxIrq: Successful transmission of a predefined number of frame descriptors. One of the descriptors matches the position programmed by the Transmit Channel Interrupt Register.
- BmRdErr: Bus error while fetching a descriptor via the bus master interface.
- Off: Bus-off condition.
- Pass: Error-passive condition.

The Tx, TxEmpty and TxIrq interrupts are only generated as the result of a successful frame transmission, only once the CanTxRD.READ pointer has been incremented.

## 26.8 Standard Mode - Reception

The receive channel is defined by the following parameters:

- base address
- buffer size
- write pointer
- read pointer

The receive channel can be enabled or disabled.

### 26.8.1 Circular buffer

The reception channel operates on a circular buffer located in memory external to GRCANFD. The circular buffer can also be used as a straight buffer. The buffer memory is accessed via the bus master interface.

The size of the buffer is defined by the SIZE field in the Reception Channel Size Register, specifying the number of CAN descriptors \* 4 that fit in the buffer.

E.g. CanRxSIZE.SIZE =2 means 8 CAN descriptors fit in the buffer.



# LEON3FT Microcontroller

Note however that it is not possible to fill the buffer completely, leaving at least one descriptor position in the buffer empty. This is to simplify wrap-around condition checking.

E.g. `CanRxSIZE.SIZE = 2` means that 7 CAN descriptors fit in the buffer at any given time.

## 26.8.2 Write and read pointers

The write pointer (WRITE field in the Reception Channel Write Register) indicates the position +1 of the last CAN descriptor written to the buffer. The write pointer operates on number of CAN descriptors, not on absolute or relative addresses.

The read pointer (READ field in the Reception Channel Read Register) indicates the position +1 of the last CAN descriptor read from the buffer. The read pointer operates on number of CAN descriptors, not on absolute or relative addresses.

The difference between the write and the read pointers is the number of CAN descriptors available in the buffer for read-out after having received a set of frames. The difference is calculated using the buffer size, specified by the `CanRxSIZE.SIZE` field, taking wrap around effects of the circular buffer into account.

Examples:

- There are 2 CAN descriptors available for read-out when `CanRxSIZE.SIZE=2`, `CanRxWR.WRITE=2` and `CanRxRD.READ=0`.
- There are 2 CAN descriptors available for read-out when `CanRxSIZE.SIZE=2`, `CanRxWR.WRITE=0` and `CanRxRD.READ=6`.
- There are 2 CAN descriptors available for read-out when `CanRxSIZE.SIZE=2`, `CanRxWR.WRITE=1` and `CanRxRD.READ=7`.
- There are 2 CAN descriptors available for read-out when `CanRxSIZE.SIZE=2`, `CanRxWR.WRITE=5` and `CanRxRD.READ=3`.

When a frame has been successfully received and all its descriptors have been stored into the circular buffer, the write pointer (`CanRxWR.WRITE`) is automatically updated, taking wrap-around effects of the circular buffer into account. If a frame consists of more than one descriptor, the pointer is not incremented one by one, but it is updated to the next position to be written to the buffer.

Whenever the read pointer `CanRxRD.READ` equals  $(\text{CanRxWR.WRITE} + 1) \bmod (\text{CanRxSIZE.SIZE} * 4)$ , there is no space available for storing another descriptor. This is signaled by an interrupt (`RxFull`). If a frame consists of more than one descriptor, `GRCANFD` will attempt to store each descriptor as long as there is space in the buffer. If there is no space for the next descriptor, the interrupt will be asserted, and `GRCANFD` will wait until the read pointer is updated to continue storing the frame.

## 26.8.3 Reception procedure

When the channel is enabled (`ENABLE` bit in the Reception Channel Control Register equal to 1b), `GRCANFD` will evaluate whether any incoming frame shall be stored into the local SRAM. To store a frame, the frame shall match the acceptance filter, which is programmable through the Acceptance Code and Acceptance Mask registers, and there shall be space available in the RX SRAM.

Once a complete frame is available, `GRCANFD` will split it into descriptors, as many as needed to represent the full frame. Then the controller will attempt to write each descriptor to the circular buffer, as long as the write and read pointers differ. This process will continue until the full frame is written to the buffer, which is signaled by the Rx interrupt and the write pointer being updated (`CanRxWR.WRITE`).

By having a local SRAM with capacity for multiple CAN-FD frames, `GRCANFD` minimizes the risk of missing frames due to conflicts accessing the AH bus or due to the RX buffer being full. Once a

# LEON3FT Microcontroller

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frame is written to the circular buffer and the write pointer is updated, the content of the SRAM can be replaced with a new frame.

Note that the channel should not be enabled until the write and read pointers are configured, to avoid the message reception to start prematurely.

The core supports generation of Overload Frames when the internal buffer is full in order to request other nodes to delay the next transmission. The core will transmit Overload Frames if the Overload Frames bit is set in the Receive Channel Control Register and the buffer is full. Up to 2 consecutive Overload Frames will be issued, according to the CAN-FD standard.

If a new frame is received before there being space available in the SRAM, the frame cannot be internally stored and the Overrun condition is detected and signaled via the corresponding interrupt (OR) and the Overrun bit in the Status Register. The OR interrupt is raised only upon the reception of the first frame which causes Overrun. If more frames are received, the OR interrupt is not raised until the Overrun condition is resolved.

Interrupts are provided to aid the user during reception, as described in detail later in this section. The main interrupts are Rx and RxIrq which are issued on the successful reception of a frame and when a predefined number of frame descriptors have been received successfully. The RxMiss interrupt is asserted whenever a frame has been received but does not match any filters (i.e. neither the acceptance nor the SYNC filters) or when a frame is received by the codec but the RX channel is disabled and consequently the frame is not stored in the circular buffer.

The RxFull interrupt is raised when there is no space in the circular buffer for storing the next descriptor. This does not only occur when a complete frame has been received and stored, but also when an individual descriptor has been stored and there is no space in the RX buffer for the following one belonging to the same frame (only applicable to FD frames). In this case, the RX Write Pointer would not represent the position currently being written, as it is only updated after all the descriptors of the frame have been stored.

The RxSync interrupt is issued when a frame matching the SYNC filter has been successfully received. Note that the frame does not need to match the acceptance filter. The interrupt is generated as soon as the CAN-FD controller finishes receiving the frame. Additional interrupts are provided to signal error conditions on the CAN bus and AMBA bus.

Regardless of the status of the RX channel, the internal CAN-FD codec will check for errors and acknowledge any incoming frames. The codec shall also evaluate frames with any identifier, even if they do not match the Acceptance or SYNC filters. The only way to prevent the internal codec from checking and acknowledging any incoming frames is to disable it via the Control Register (ENABLE bit).

## 26.8.4 AMBA error

An error response occurring on the AMBA bus while a frame descriptor is being stored will result in a BmWrErr interrupt. Consequently the bit BMErr of the Status Register is set to 1b, and it can only be cleared when that register is read.

If the CanCONF.ABORT bit is set to 0b, GRCANFD will retry to write the same descriptor to the circular buffer.

If the CanCONF.ABORT bit is set to 1b, the RX channel will be disabled (CanRxCTRL.ENABLE is cleared automatically to 0b). The write pointer can be used to determine which frame caused the bus master error (but not the specific descriptor, if the frame contains more than one). Any ongoing reception is aborted, and the local SRAM is emptied. The descriptor causing the error is not stored and the write pointer is therefore not updated.

# LEON3FT Microcontroller

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## 26.8.5 Enable and disable

When the RX channel is disabled (ENABLE bit in the Reception Channel Control Register cleared to 0b) while a frame is being written to the circular buffer, the core will still complete this operation before effectively switching off the channel, thus updating the write pointer (CanRxWR.WRITE) and generating the corresponding interrupts.

When the Receive Channel is disabled, the content of the internal SRAM is emptied once any pending operations are finalized, so that the buffer is fully available once the channel is enabled again.

The progress of an ongoing reception can be observed via the ONGOING bit in the Reception Channel Control Register. The ONGOING bit must be 0b before the channel can be re-configured safely (i.e. changing address, size or write pointer).

GRCANFD includes a status bit in the RX channel control register called DisACK. This bit is used to indicate that the RX channel disable request has been acknowledged, and will take effect as soon as the ongoing reception finishes and the frame is stored into the circular buffer, or until it fails to complete. The RX channel is not completely disabled until both ENABLE and DisACK are both 0b.

The channel can be re-enabled again without the need to re-configure the address, size and pointers.

## 26.8.6 Interrupts

During reception several interrupts can be generated:

- RxMiss: Frame filtered away during reception
- RxErrCnt: Receive error counter incremented.
- RxSync: Frame matching the SYNC filter received.
- Rx: Successful reception of a frame and storage into the circular buffer.
- RxFull: RX buffer full; no space for the next frame descriptor.
- RxIrq: Successful reception of a predefined number of frame descriptors. One of the descriptors of the frame matches the position programmed by the Receive Channel Interrupt Register.
- BmWrErr: Bus error while storing a frame descriptor via the bus master interface.
- OR: Overrun during reception.
- OFF: Bus-off condition.
- PASS: Error-passive condition.

The Rx and RxIrq interrupts are only generated as the result of a successful frame reception, after the CanRxWR.WRITE pointer has been incremented. RxFull may be generated when a descriptor is stored, regardless of whether it is the last one within a frame or not.

The OR interrupt is generated when a frame is received but the internal SRAM already contains the maximum number of frames yet to be stored into the circular buffer. This may be due to a conflict accessing the bus via the bus master interface, or to the RX circular buffer being full. The assertion of this interrupt implies that one or more frames have already been missed. Once this occurs, the Overrun bit of the Status Register is set to 1b, and will only be cleared by reading the mentioned register.

## 26.9 CANOpen mode

### 26.9.1 General

GRCANFD features a minimal implementation of the CANOpen standard. This allows an external CAN node to access the internal address space of the device via specific messages defined in CANOpen.

# LEON3FT Microcontroller

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The controller contains an FSM to handle CANOpen commands. GRCANFD will not transmit any frame spontaneously, it shall be triggered by the master node of the bus. Once a CAN frame is received, the controller will check its format and decode it. The frame shall be a classical CAN data frame, i.e. the bits RTR, FDF and BRS shall be all 0b. Frames not matching this criteria are silently discarded.

A separate bus master interface is used for all AMBA accesses performed in CANOpen mode.

When decoding the frame, the controller checks the function code (bits 11-8 of the base ID) and the destination node ID (bits 7-0 of the base ID) of the command. If the command is supported by the IP, the corresponding process is triggered, otherwise the command is silently discarded. Supported commands include PDOs 1-4, SYNC and Heartbeat messages. A detailed description of each command and the usage of their data bytes can be found later in this section.

The PDOs 1 and 3 are mapped to write commands, in which the user shall indicate the target AMBA address and the data to write. The controller supports write accesses of 1-4 bytes, depending on the DLC field of the frame. Once the internal write access to the AMBA bus is finalized, the FSM returns to idle state and an interrupt is generated.

The PDOs 2 and 4 are mapped to read commands, in which the user shall indicate the target AMBA address and, optionally, the number of bytes to read. The controller supports read accesses of 0-8 bytes. If no reply length is indicated, the default access is 4 bytes. Once the internal read access to the AMBA bus is finalized, GRCANFD transmits the reply with the requested data. The FSM returns to idle state when the codec has successfully transmitted the frame, and an interrupt is generated.

For all PDOs, the controller supports the reception of RPDOs and, for read commands, the transmission of the corresponding TPDO with the reply.

The Heartbeat command is used to keep alive the bus. If enabled, GRCANFD features an internal counter that is incremented every CAN bit time (i.e. with the Sample Point of the CAN bus). Every time a Heartbeat command is received, the counter is reset. If the counter reaches the programmed timeout, the controller will generate an interrupt and, optionally, switch to the alternate CAN bus, by inverting the LineSel bit in the Configuration Register. This functionality can be enabled in the CANOpen Control Register with the Redundant Control bit.

The SYNC command is used to synchronize all nodes in the network. When GRCANFD receives a SYNC command, an interrupt is generated. Software is required to handle the node synchronization in this case.

If GRCANFD receives a frame which does not pass the preliminary format check (e.g. the frame has FD format or is a Remote Frame) or it does not match any CANOpen object supported, it generates the RxMiss interrupt and the frame is discarded. Then, the controller starts listening to the CAN bus again waiting for the next frame.

## 26.9.2 Write commands

Write commands are mapped to the CANOpen PDOs 1 and 3, and are used to trigger an internal AMBA write access. Both PDOs will result in the same functionality. The format of the incoming PDOs shall be as follows:

- Frame format: Classical CAN data frame.
- Function code: RPDO1 (0100b) or RPDO3 (1000b).
- Destination node: GRCANFD node ID (node ID field in the CANOpen Control Register).
- DLC: 5 - 8

The DLC field is used to indicate the size of the AMBA write access. The controller supports write accesses of 1 - 4 bytes per PDO. The AMBA address is mapped to the data bytes 1 - 4 of the frame (the first byte being the MSB and the fourth byte the LSB), whereas the data bytes 5 - 8 represent the data to write (the fifth byte being the MSB and the last byte the LSB).



Figure 52. Use of data bytes in write commands (RPDO1 and RPDO3)

Any write command with less than 5 data bytes is simply ignored, as it would not contain enough information to trigger an internal AMBA write access.

### 26.9.3 Read commands

Read commands are mapped to the CANOpen PDOs 2 and 4, and are used to trigger an internal AMBA read access. Both PDOs will result in the same functionality. The format of the incoming PDOs shall be as follows:

- Frame format: Classical CAN data frame.
- Function code: RPDO2 (0110b) or RPDO4 (1010b).
- Destination node: GRCANFD node ID (node ID field in the CANOpen Control Register).
- DLC: 4 or 5

The size of the AMBA read access is configurable. If the frame contains 4 data bytes (DLC = 4), a standard 32-bit read access is performed. The AMBA address is mapped to these first 4 data bytes of the frame (the first byte being the MSB).

GRCANFD also supports AMBA read accesses of configurable size by means of frames with 5 data bytes (DLC = 5). The four data bytes are still the AMBA address, whereas the fifth byte indicates the size of the read access in number of bytes. Valid sizes range from 0 to 8 bytes, the controller will cap the value to the maximum of 8 bytes.

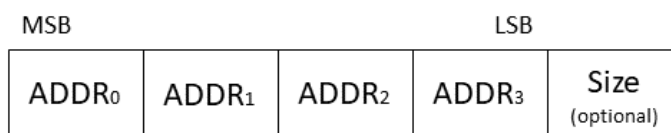


Figure 53. Use of data bytes in read commands (RPDO2 and RPDO4)

Any read command with DLC other than 4 or 5 is silently discarded by the IP.

Once GRCANFD has completed the internal AMBA read access, it will transmit a TPDO with the data requested as soon as the intermission time (3 bits of nominal CAN bit-rate) is over. The main characteristics of the reply are listed below:

- Frame format: Classical CAN data frame.
- Function code: TPDO2 (0101b) if replying to an RPDO2, or TPDO4 (1001b) for an RPDO4.
- Destination node: GRCANFD node ID (node ID field in the CANOpen Control Register).
- DLC: 0 - 8, according to the size field of the read command (4 by default).

The first data byte of the reply TPDO is the MSB and the last byte, the LSB. Note that it is possible to request the transmission of a TPDO without any data bytes by setting the size of the read access to 0. In this case, no internal read access is performed, and the DLC of the reply is set to 0 accordingly.

### 26.9.4 SYNC commands

The SYNC commands are employed to synchronize the slave nodes in a CAN bus. Once a frame is interpreted as a SYNC command, GRCANFD triggers an interrupt to be handled by software. The

# LEON3FT Microcontroller

controller does not maintain any internal synchronization timer. The format of the incoming SYNC command is as follows:

- Frame format: Classical CAN data frame.
- Function code: SYNC (0001b).
- Destination node: broadcast (0000000b).

Note that the DLC and the data bytes of a SYNC command are neither checked nor used by the IP.

## 26.9.5 Heartbeat commands

The Heartbeat command is used as the NMT Error Control mechanism to keep the bus alive. GRCANFD features an internal counter incremented once per CAN bit time if the NMT Error Control functionality is enabled, which is done by setting the CANOpen Heartbeat Timeout Register to a value different from zero. The timeout is expressed in number of CAN bit times.

Every time a Heartbeat command is received, GRCANFD restarts the counter. If the timeout is reached, an interrupt is triggered and the controller may switch to the alternate bus by inverting the LineSel signal of the Configuration Register. This behavior is controlled via the Redundant Control bit in the CANOpen Control Register.

The format of the Heartbeat command shall be as follows:

- Frame format: Classical CAN data frame.
- Function code: NMT Error Control / Heartbeat (1110b).
- Destination node: GRCANFD node ID (node ID field in the CANOpen Control Register).

Note that the DLC and the data bytes of a Heartbeat command are neither checked nor used by the IP.

## 26.9.6 AMBA errors

As in the standard mode, the CANFD core will raise an interrupt if any access to the internal AMBA bus ends with errors. The CANOpen mode uses the same Bus Master Error interrupt bits as the standard mode. Therefore, if an AMBA write access triggered by a CANOpen write command ends with errors, the controller will raise the BmWrErr interrupt. On the other hand, if the errors are observed during a read access triggered by a CANOpen read command, the corresponding BmRdErr interrupt is raised.

The CANFD does not use the Abort bit of the Configuration Register, unlike the standard mode. In CANOpen mode, AMBA accesses are never retried (i.e. this corresponds to Abort bit set to 1b) in order to prevent the controller from locking if an external node targeted an invalid AMBA address. Therefore, the internal CANOpen FSM will automatically return to idle after any bus master errors without processing the command. The corresponding interrupt is generated as explained in the paragraph above.

## 26.9.7 Interrupts

GRCANFD includes four maskable interrupts exclusive to the CANOpen mode:

- CoHbErr: CANOpen Heartbeat timeout error
- CoSync: SYNC command received
- CoWrCmd: CANOpen write command processed
- CoRdCmd: CANOpen read command processed

Note that the CANFD can still produce other general interrupts in CANOpen mode, such as those related to the CAN error counters, loss of arbitration or bus master errors. More information can be found under the Register section, in 26.11.28.

# LEON3FT Microcontroller

## 26.10 CANFD reset and enable

When the RESET bit in the Control Register is set to 1b, a reset of the whole controller is performed, including the internal CAN-FD codec. The reset clears all the register fields to their default values. Any ongoing frame transfer request will be aborted, potentially violating the CAN protocol.

When the ENABLE bit in the Control Register is cleared to 0b, the CAN-FD codec is reset, so it is safe to modify the configuration registers. When disabled, the CAN-FD controller will be in sleep mode. It will only send recessive bits thus not affecting the CAN bus. It will neither receive nor acknowledge any frame on the bus.

Once the codec is enabled again, it will enter bus integration state before being able to transmit or receive frames. It requires that 11 consecutive recessive bits are detected in the CAN bus prior to starting the normal operation.

## 26.11 Registers

The core is programmed through registers mapped into APB address space.

Table 247. GRCANFD registers

APB address offset	Register
0x000	Configuration Register
0x004	Status Register
0x008	Control Register

# LEON3FT Microcontroller

Table 247. GRCANFD registers

APB address offset	Register
0x00C	Capability Register
0x018	SYNC Mask Filter Register
0x01C	SYNC Code Filter Register
0x040	Nominal Bit-Rate Configuration Register
0x044	Data Bit-Rate Configuration Register
0x048	Transmitter Delay Compensation Register
0x080	CANOpen Control Register
0x084	CANOpen Heartbeat Timeout Register
0x088	CANOpen Heartbeat Count Register
0x08C	CANOpen Status Register
0x100	Pending Interrupt Masked Status Register
0x104	Pending Interrupt Masked Register
0x108	Pending Interrupt Status Register
0x10C	Pending Interrupt Register
0x110	Interrupt Mask Register
0x114	Pending Interrupt Clear Register
0x200	Transmit Channel Control Register
0x204	Transmit Channel Address Register
0x208	Transmit Channel Size Register
0x20C	Transmit Channel Write Register
0x210	Transmit Channel Read Register
0x214	Transmit Channel Interrupt Register
0x300	Receive Channel Control Register
0x304	Receive Channel Address Register
0x308	Receive Channel Size Register
0x30C	Receive Channel Write Register
0x310	Receive Channel Read Register
0x314	Receive Channel Interrupt Register
0x318	Receive Channel Acceptance Mask Register
0x31C	Receive Channel Acceptance Code Register

## 26.11.1 Configuration Register

Table 248. 0x000 - CONF - Configuration Register

31	8	7	6	5	4	3	2	1	0
Reserved	LBS	LB	Res	Silent	Select	Enable1	Enable0	Abort	
0x000000	0	0	0	0	0*	0*	0*	0	
r	rw	rw	r	rw	rw	rw	rw	rw	rw

- 7: LBS Loop-back selector. Selects between external (0b) and internal (1b) loop-back. Used only if LB is set.
- 6: LB Loop-back mode. When transmitting a frame, the core will drive the ACK bit and store its own frames.
- 4: SILENT Listen only to the CAN bus, send recessive bits.
- 3: SELECT Line selector for transmitter and receiver:  
 Select receiver input 0 and transmitter output 0 as active when 0b,  
 Select receiver input 1 and transmitter output 1 as active when 1b.



# LEON3FT Microcontroller

- 2: ENABLE1 Set value of output 1 enable. Its polarity depends on the physical transceiver.
- 1: ENABLE0 Set value of output 0 enable. Its polarity depends on the physical transceiver.
- 0: ABORT Abort transfer after AMBA bus errors (standard-mode only).

\* The reset value of these fields may be overwritten with the input configuration signals (cfg record) in *canopen* mode.

By setting the ABORT bit to 1b, the TX and RX channels are automatically disabled upon detection of an AMBA bus error. Otherwise, the transfer causing the error is issued again. Note that in CANOpen mode, any AMBA accesses resulting in errors are always aborted, regardless of the value of this bit. This prevents any external CAN node from locking the controller if accessing an invalid or protected AMBA address.

When the loop-back mode is enabled, GRCANFD will drive the ACK bit of its own frames. Additionally, these frames will be stored in the RX circular buffer as received frames. The loop-back selector allows to connect the TX and RX bits inside the IP, thus bypassing the external CAN transceiver (internal loop-back), and to have a standard connection to the CAN bus (external loop-back).

The core will only transmit recessive bits over the CAN bus when either the internal loop-back or the Silent mode is activated.

## 26.11.2 Status Register

Table 249.0x004 - STAT - Status Register

31	24	23								16
Reserved		TxErrCntr								
0x00		0x00								
r		r								
15	8	7	6	5	4	3	2	1	0	
RxErrCntr		Reserved	MD	Active	BM Err	OR	Bus Off	Err Pass		
0x00		0x0	0	0	0	0	0	0		
r		r	r	r	r	r	r	r		

- 23-16: TxErrCntr Transmission error counter, 8-bit
- 15-8: RxErrCntr Reception error counter, 8-bit
- 5: MD GRCANFD operational mode: standard (0b) or CANOpen (1b)
- 4: ACTIVE Transmission ongoing
- 3: BMErr Errors detected during a previous transfer via the bus master interface
- 2: OR Overrun during reception
- 1: Bus Off Bus-off condition
- 0: Err Pass Error-passive condition

The OR bit is set if a frame with an ID matching the acceptance filter cannot be stored within the local SRAM due to lack of space, i.e. the SRAM already is full of CAN messages yet to be stored into the circular buffer

The OR and BMErr status bits are cleared when the Status Register is read.

Note that TxErrCntr and RxErrCntr are defined and updated according to the CAN protocol.

Additionally, the fields TxErrCntr, RxErrCntr, BMErr, OR, Bus Off and Error Passive are stored in the circular buffer during reception as part of the first descriptor of every frame.

The MD bit indicates the mode in which GRCANFD operates. This bit only changes once all conditions to switch from one mode to the other are satisfied.

# LEON3FT Microcontroller

## 26.11.3 Control Register

Table 250.0x008 - CTRL - Control Register

31	2	1	0
Reserved	Reset	Enable	
0x00000000	0	0*	
r	w	rw	

- 1: RESET Reset complete core when 1. Self-clearing.
- 0: ENABLE Enable CAN-FD codec when 1. Disable CAN-FD codec when 0.

\* The reset value of this field may be overwritten with the input configuration signals (cfg record) if *canopen* mode is used.

RESET takes effect on the whole IP, including the internal codec. It is self-clearing, so it is read back as 0b.

The internal codec shall be disabled by setting ENABLE to 0 before modifying any CAN-related settings, such as the configuration of the bit times. This ensures that the integration with the CAN bus is correctly performed.

When ENABLE is cleared to 0b, the CAN interface is in sleep mode, only outputting recessive bits.

Once the CAN-FD codec is enabled again, it needs to detect 11 consecutive recessive bits on the CAN bus prior to starting the normal operation, i.e. transmit or receive any frame.

## 26.11.4 Capability Register

Table 251.0x00C - CAP - Capability Register

31	11	10	8	7	6	4	3	1	0
Res	TxBufSize		Res	RxBufSize		Res		Sing IRQ	
1100...0	-		0	-		000		-	
r	r		r	r		r		r	

- 10-8: TxBufSizeSize of the internal TX buffer, expressed in number of frames - 1.
- 6-4: RxBufSizeSize of the internal RX buffer, expressed in number of frames - 1.
- 0: SingIRQThe controller has a single IRQ output if SingIRQ is set to 1b, otherwise there are three different interrupts.

The capability register contains general information about the instantiation of the IP.

If SingIRQ is set to 1b, the controller combines all the interrupts in a single interrupt output. If set to 0b, GRCANFD features up to 3 interrupt outputs: a common line, together with dedicated lines for TxSYNC and RxSYNC interrupts, respectively.

## 26.11.5 SYNC Mask Filter Register

Table 252.0x018 - SYNCMASK - SYNC Mask Filter Register

31	30	29	28	0
Reserved			MASK	
0x0			0x1FFFFFFF	
r			rw	

- 28-0: MASK Mask for SYNC filter

# LEON3FT Microcontroller

All bits of the MASK field are set to 1 at reset.

Note that Base ID corresponds to the bits 28 to 18 and Extended ID corresponds to bits 17 to 0.

## 26.11.6 SYNC Code Filter Register

Table 253. 0x01C - SYNCCODE - SYNC Code Filter Register

31	30	29	28	0
Reserved			CODE	
0x0			0x00000000	
r			rw	

28-0: CODE Code for SYNC filter

The CAN Base ID corresponds to the bits 28 to 18 and Extended ID corresponds to bits 17 to 0.

The SYNC filter is applied to the transmitted frames as soon as the codec transmits the frame. For the RX channel, the filter is applied as soon as the codec receives the frame, regardless of whether the frame is to be stored into the circular buffer afterwards, so it does not depend on the configuration of the Acceptance filter. Specific interrupts are available for both SYNC filters.

An ID matches the RxSYNC filter when:

$$((\text{Received-ID}) \text{ XOR } (\text{SYNC CODE})) \text{ AND } (\text{SYNC MASK}) = 0$$

An ID matches the TxSYNC filter when:

$$((\text{Transmitted-ID}) \text{ XOR } (\text{SYNC CODE})) \text{ AND } (\text{SYNC MASK}) = 0$$

## 26.11.7 Nominal Bit-Rate Configuration Register

Table 254. 0x040 - NOMBR - Nominal Bit-Rate Configuration Register

31	24	23	16	
Reserved		SCALER		
0x00		0x00*		
r		rw		
15	10	9	5 4 0	
PS1		PS2		SJW
0x00*		0x00*		0x00*
rw		rw		rw

23-16: SCALER Prescaler setting for nominal bit rate, 8-bit: system clock / (SCALER + 1)

15-10: PS1 Phase Segment 1 for nominal bit rate, 6-bit

9-4: PS2 Phase Segment 2 for nominal bit rate, 5-bit

3-0: SJW Synchronization Jump Width, 5-bit

\* The reset value of these fields may be overwritten with the input configuration signals (cfg record).

The prescaler sets the number of clock cycles per nominal time quantum (plus an offset of 1). PS1, PS2 and SJW define the number of nominal quantum within the Phase Segment 1, Phase Segment 2 and Synchronization Jump Width, respectively.

Certain constraints apply to the previous parameters. Since GRCANFD is an FD enabled implementation with separate prescalers for the nominal and the data bit rate, the valid ranges are as follows:

- Prescaler: 0 - 255
- PS1: 2 - 63

# LEON3FT Microcontroller

- PS2: 2 - 16
- SJW: 1 - 16

Additional considerations must be taken when defining the parameters:

- PS2 >= SJW
- SJW <= min (PS1, PS2)

For more information regarding the parameters defining the nominal bit time, please refer to the ISO standard 11898-1:2015 (2nd edition).

Therefore, the Nominal time quantum can be obtained as follows:

$$(\text{system clock period}) * (\text{SCALER}+1)$$

whereas the resulting Nominal bit rate is:

$$(\text{system clock frequency}) / ((\text{SCALER}+1) * (1+ \text{PS1} + \text{PS2}))$$

## 26.11.8 Data Bit-Rate Configuration Register

Table 255.0x044 - DATABR - Data Bit-Rate Configuration Register

31										24				23				16				
Reserved										SCALER												
0x00										0x00												
r										rw												
15			14		13		10			9		8		5			4		3		0	
Reserved			PS1				Res.		PS2				Res.		SJW							
00			0x0				0		0x0				0		0x0							
r			rw				r		rw				r		rw							

- 23-16: SCALER Prescaler setting for data bit rate, 8-bit: system clock / (SCALER + 1)
- 13-10: PS1 Phase Segment 1 for data bit rate, 4-bit
- 8-5: PS2 Phase Segment 2 for data bit rate, 4-bit
- 3-0: SJW Synchronization Jump Width, 4-bit

The prescaler sets the number of clock cycles per data time quantum (plus an offset of 1). PS1, PS2 and SJW define the number of data quantum within the Phase Segment 1, Phase Segment 2 and Synchronization Jump Width, respectively.

Certain constraints apply to the previous parameters. Since GRCANFD is an FD enabled implementation with separate prescalers for the nominal and the data bit rate, the valid ranges are as follows:

- Prescaler: 0 - 255
- PS1: 1 - 15
- PS2: 2 - 8
- SJW: 1 - 8

Additional considerations must be taken when defining the parameters:

- SJW <= min (PS1, PS2)
- Data bit-rate >= Nominal bit-rate

For more information regarding the parameters defining the data bit time, please refer to the ISO standard 11898-1:2015 (2nd edition).

Therefore, the Data time quantum can be obtained as follows:

$$(\text{system clock period}) * (\text{SCALER}+1)$$

# LEON3FT Microcontroller

whereas the resulting Data bit rate is:

$$(\text{system clock frequency}) / ((\text{SCALER}+1) * (1+ \text{PS1} + \text{PS2}))$$

## 26.11.9 Transmitter Delay Compensation Register

Table 256.0x048 - DELCOMP - Transmitter Delay Compensation Register

31	6	5	0
Reserved	TxCompVal		
0x0000000	0x00		
r	rw		

5-0: TxCompVal Number of time quantum for the transmitter delay compensation.

This register configures the delay in terms of number of data quantum to be compensated during the data phase of an FD frame. A maximum of 2 data bit times may be compensated.

If set to 0, the transmitter delay compensation is internally disabled. Otherwise, the register defines the delay between the synchronization segment of a bit and its corresponding secondary sample point, when the signal may be safely read-back.

## 26.11.10 CANOpen Control Register

Table 257.0x080 - COCTRL- CANOpen Control Register

31	11	10	4	3	2	1	0
Reserved	ID		Res	RC	SS	EN	
0x0000000	1111111*		0	0	0	0*	
r	rw		r	rw	rw	rw	

- 10-4: ID CANOpen Node ID. Used to determine if the input commands shall be processed by GRCANFD.
- 2: RC Redundant Control. If set, the controller will switch to the alternate CAN bus after a Heartbeat Timeout error.
- 1: SS Single-shot mode. If set, the controller will not retry to transmit a reply if it fails due to errors or arbitration.
- 0: EN Enable CANOpen mode when set to 1b.

\* The reset value of these fields may be overwritten with the input configuration signals (cfg record) (TBD).

## 26.11.11 CANOpen Heartbeat Timeout Register

Table 258.0x084 - COHBTO- CANOpen Heartbeat Timeout Register

31	0
TO	
0x00000000	
rw	

31-0: TO Heartbeat Timeout expressed as number of CAN bit times. Once the timeout is reached without receiving a Heartbeat command, GRCANFD will trigger an interrupt.

# LEON3FT Microcontroller

## 26.11.12 CANOpen Heartbeat Count Register

Table 259.0x088 - COHBCT- CANOpen Heartbeat Count Register

31	0
CT	
0x00000000	
r	

31-0: CT Heartbeat internal counter expressed as number of CAN bit times. Restarted every time a Heartbeat command is received. Read-only.

## 26.11.13 CANOpen Status Register

Table 260.0x08C - COSTS- CANOpen Status Register

31	4	3	0
Reserved		STS	
0x00000000		0x0	
r		r	

3-0: STS Status of the CANOpen FSM, encoded as follows:  
 0x0: IDLE. Listening to the CAN bus while waiting for a new RX frame.  
 0x1: RX\_DATABYTES. A frame passing the preliminary format check is being received.  
 0x2: DECODE. The reception has ended and the Controller checks if the frame is a CANOpen object.  
 0x3: INIT\_WRITE. Initializing an AMBA write access after receiving a CANOpen write command.  
 0x4: END\_WRITE. Waiting for the end of the write access.  
 0x5: INIT\_READ. Initializing an AMBA read access after receiving a CANOpen read command.  
 0x6: END\_READ. Waiting for the end of the read access.  
 0x7: INIT\_REPLY. Initializing the TPDO as a reply to a CANOpen read command.  
 0x8: TX\_DATABYTES. Transmitting the TPDO.  
 0x9: REPLY\_NOK. The TPDO failed during transmission due to errors or loss of arbitration.

## 26.11.14 Transmit Channel Control Register

Table 261.0x200 - TXCTRL - Transmit Channel Control Register

31	4	3	2	1	0	
Reserved			Dis Ack	Sin- gle	Ong oing	Ena ble
0x00000000			0	0	0	0
r			r	rw	r	rw

3: DisAck Disable request acknowledged  
 2: SINGLE Single shot mode  
 1: Ongoing Transmission ongoing  
 0: ENABLE Enable channel

The TX channel is enabled by setting ENABLE to 1b.

The Ongoing bit indicates whether the codec is transmitting a frame. If the TX channel is disabled while Ongoing is set to 1, the TX channel is disabled, but any ongoing transmission will continue until it finishes (either successfully or with errors). In this case, the DisACK bit is set to 1b to indicate the user that the TX channel will be completely disabled as soon as the ongoing transmission ends.

Changing the configuration of the TX channel (pointers, parameters of the buffer) is not safe when ongoing is set to 1b. The user shall wait until the TX channel is effectively disabled by monitoring both DisACK and ENABLE. When both are set to '0', the codec is no longer transmitting a frame, so the TX channel can be safely reconfigured.

# LEON3FT Microcontroller

If the single shot mode is enabled, the TX channel will be automatically disabled when a transmission does not complete successfully. This may be due to loss of arbitration, transmission errors, ACK not being sent by the receivers, etc. In this case, the content of the SRAM is removed to avoid blocking any future transmission and GRCANFD does not update the TX read pointer.

The TX channel will also be automatically disabled if the ABORT bit is set to 1b in the Configuration Register, and an AMBA error occurs while fetching a descriptor from the circular buffer. If the codec is transmitting a frame in parallel, the transmission is not interrupted, since that frame did not cause the error accessing the bus (a transmission only starts when all the descriptors describing the frame are fetched).

## 26.11.15 Transmit Channel Address Register

Table 262.0x204 - TXADDR - Transmit Channel Address Register

31	10	9	0
ADDR	Reserved		
0	0x000		
rw	r		

31-10: ADDR Base address for TX circular buffer

## 26.11.16 Transmit Channel Size Register

Table 263.0x208 - TXSIZE - Transmit Channel Size Register

31	21	20	6	5	0
Reserved		SIZE		Reserved	
0x000		0x0000		0x00	
r		rw		r	

20-6: SIZE The size of the TX circular buffer is SIZE\*4 descriptors

Valid SIZE values are between 0 and 16384.

Each descriptor occupies four 32-bit words. A frame may consist of 1 to 5 descriptors depending on its format and data length.

Note that the resulting behavior of invalid SIZE values is undefined.

Note that only (SIZE\*4)-1 descriptors can be stored simultaneously in the buffer. This is to simplify wrap-around condition checking.

## 26.11.17 Transmit Channel Write Register

Table 264.0x20C - TXWR - Transmit Channel Write Register

31	20	19	4	3	0
Reserved		WRITE		Reserved	
0x000		0x0000		0x0	
r		rw		r	

19-4: WRITE Pointer to last written descriptor+1

The WRITE field is written to in order to initiate a transfer, indicating the position +1 of the last descriptor to transmit.

# LEON3FT Microcontroller

Note that it is not possible to fill the buffer. There is always one descriptor position in buffer unused. Software is responsible for not over-writing the buffer on wrap around (i.e. setting WRITE=READ).

The field is implemented as relative to the buffer base address (scaled with the SIZE field).

GRCANFD reads this register to know if there are more descriptors to fetch. While operating, it will never modify the write pointer, unless the core is being reset.

## 26.11.18 Transmit Channel Read Register

Table 265.0x210 - TXRD - Transmit Channel Read Register

31	20	19	4	3	0
Reserved		READ		Reserved	
0x000		0x0000		0x0	
r		rw		r	

19-4: READ Pointer to last read descriptor+1

The READ field is written to automatically by the core when a transfer has been completed successfully, indicating the position +1 of the last descriptor transmitted. If a frame consists of more than 1 descriptor, GRCANFD will not increment the pointer one by one, but update it with the final position directly.

Note that the READ field can be use to read out the progress of a transfer of a set of frames.

Note that the READ field can be written to in order to set up the starting point of a transfer. This should only be done while the transmit channel is not enabled and the codec is not transmitting any frame.

Note that the READ field may be incremented even if the transmit channel has been disabled, in case the codec was already transmitting a frame when the ENABLE was set to 0b. As explained previously, this is indicated by both the Ongoing and the DisACK bits of the TX control register.

When the Transmit Channel Read Pointer catches up with the Transmit Channel Write Register, an interrupt is generated (TxEmpty). Note that this implies that all descriptors stored in the buffer have been transmitted.

The field is implemented as relative to the buffer base address (scaled with the SIZE field).

## 26.11.19 Transmit Channel Interrupt Register

Table 266.0x214 - TXIRQ - Transmit Channel Interrupt Register

31	20	19	4	3	0
Reserved		IRQ		Reserved	
0x000		0x0000		0x0	
r		rw		r	

19-4: IRQ Interrupt is generated when the value in the Tx Read register becomes equal to IRQ, as a consequence of the transmission of a frame

This register configures the interrupt TxIRQ, which indicates that a programmed number of descriptors have been transmitted.

The field is implemented as relative to the buffer base address (scaled with the SIZE field).

Since CAN-FD frames may consist of up to 5 descriptors, the TX read pointer may be incremented internally several times per frame. The content of this register is therefore compared with the TX read pointer after each increment. This means that the interrupt will be asserted if the position of any of the



# LEON3FT Microcontroller

descriptors conforming the frame matches the programmed position. Note that the interrupt is only generated once the transmission of the frame is successfully completed.

## 26.11.20 Receive Channel Control Register

Table 267.0x300 - RXCTRL - Receive Channel Control Register

31	4	3	2	1	0
Reserved	OF	Dis Ack	Ong oing	Ena ble	
0x0000000	0	0	0	0	
r	rw	r	r	rw	

- 3: OF Overload Frame enable
- 2: DisAck Disable request acknowledged
- 1: ONGOING Reception ongoing (read-only)
- 0: ENABLE Enable channel

The RX channel is enabled by setting ENABLE to 1b.

The Ongoing bit indicates that a reception is taking place. There are two scenarios for this: the codec may be receiving the frame, or the frame has already been received, matches the acceptance filter and it is yet to be written to the circular buffer.

If the user disables the RX channel by setting ENABLE to 0b, any ongoing write access over the AMBA bus will finish. If it was the last descriptor of a frame, the reception is complete and the pointers, status registers and interrupts are updated accordingly. The DisACK bit is then set to 1b to acknowledge the disable request, and is cleared as soon as the RX channel is effectively disabled.

The RX channel may not be configured while Ongoing is 1b, as this may disrupt the status of the CAN bus. The user shall monitor both Ongoing and DisACK bits: when both are 0b and the channel has been disabled, it is safe to modify the configuration of the RX channel.

The RX channel is automatically disabled if the ABORT bit is set to 1b in the Configuration Register and an AMBA error is detected when accessing the bus.

The content of the RX SRAM is emptied whenever the RX channel is effectively disabled.

## 26.11.21 Receive Channel Address Register

Table 268.0x304 - RXADDR - Receive Channel Address Register

31	10	9	0
ADDR	Reserved		
0x000000	0x000		
rw	r		

- 31-10: ADDR Base address for RX circular buffer

# LEON3FT Microcontroller

## 26.11.22 Receive Channel Size Register

Table 269.0x308 - RXSIZE - Receive Channel Size Register

31	21	20	6	5	0
Reserved		SIZE		Reserved	
0x000		0x0000		0x00	
r		rw		r	

20-6: **SIZE** The size of the RX circular buffer is SIZE\*4 descriptors

Valid SIZE values are between 0 and 16384.

Note that each descriptor occupies four 32-bit words. A frame may consist of 1 to 5 descriptors depending on its format and data length.

Note that the resulting behavior of invalid SIZE values is undefined.

Note that only (SIZE\*4)-1 descriptors can be stored simultaneously in the buffer. This is to simplify wrap-around condition checking.

## 26.11.23 Receive Channel Write Register

Table 270.0x30C - RXWR - Receive Channel Write Register

31	20	19	4	3	0
Reserved		WRITE		Reserved	
0x000		0x0000		0x0	
r		rw		r	

19-4: **WRITE** Pointer to last written descriptor +1

The field is implemented as relative to the buffer base address (scaled with the SIZE field).

The WRITE field is written to automatically when a transfer has been completed successfully, indicating the position +1 of the last descriptor received. For frames consisting of more than 1 descriptor, GRCANFD will not increment the Write pointer one by one, but update it with the final position directly.

The Write pointer may be updated even after disabling the RX channel. This may be due to the fact that there was a frame being received or already in the local SRAM, and the storage takes place after the disable request.

Note that the WRITE field can be use to read out the progress of a transfer of a set of frames.

Note that the WRITE field can be written to in order to set up the starting point of a transfer. This should only be done while the receive channel is not enabled.

If the RX write pointer catches up with the read pointer, there is no space in the buffer for any additional descriptor. An interrupt is asserted informing that the buffer is full. GRCANFD will detect this and transmit up to 2 consecutive Overload Frames to delay the reception of the next frame. If a new frame arrives under this circumstance, the controller misses it and the Overrun bit in the Status Register is set, together with the Overrun interrupt.

# LEON3FT Microcontroller

## 26.11.24 Receive Channel Read Register

Table 271.0x310 - RXRD - Receive Channel Read Register

31	20	19	4	3	0
Reserved		READ		Reserved	
0x000		0x0000		0x0	
r		rw		r	

19-4: READ Pointer to last read descriptor +1

The field is implemented as relative to the buffer base address (scaled with the SIZE field).

The READ field is written to in order to release the receive buffer, indicating the position +1 of the last descriptor that has been read out.

Note that it is not possible to fill the buffer. There is always one descriptor position in buffer unused. Software is responsible for not over-reading the buffer on wrap around (i.e. setting WRITE=READ).

GRCANFD will never modify the RX read pointer, unless the controller is being reset.

## 26.11.25 Receive Channel Interrupt Register

Table 272.0x314 - RXIRQ - Receive Channel Interrupt Register

31	20	19	4	3	0
Reserved		IRQ		Reserved	
0x000		0x0000		0x0	
r		rw		r	

19-4: IRQ Interrupt is generated when the value in the Rx Write register becomes equal to IRQ, as a consequence of reception of a message

This register configures the interrupt which indicates that a programmed number of descriptors have been received.

The field is implemented as relative to the buffer base address (scaled with the SIZE field).

Since CAN-FD frames may consist of up to 5 descriptors, the RX write pointer may be incremented internally several times per frame. The content of this register is therefore compared with the RX write pointer after each increment. This means that the interrupt will be asserted if the position of any of the descriptors conforming the frame matches the programmed position. Note that the interrupt is only generated once the storage of the frame is successfully completed.

## 26.11.26 Receive Channel Acceptance Mask Register

Table 273.0x318 - RXMASK - Receive Channel Acceptance Mask Register

31	30	29	28	0
Reserved			AM	
000			0x1FFFFFFF	
r			rw	

28-0: AM Acceptance Mask: bits set to 1b are taken into account in the comparison between the received frame ID and the CanRxCODE.AC field

All bits are set to 1 at reset.

Note that Base ID corresponds to the bits 28 to 18 and Extended ID corresponds to the bits 17 to 0.

## 26.11.27 Receive Channel Acceptance Code Register

Table 274.0x31C - RXCODE - Receive Channel Acceptance Code Register

31	30	29	28	0
Reserved		AC		
000		0x00000000		
r		rw		

28-0: AC Acceptance Code, used in comparison with the received frame ID

Note that Base ID corresponds to the bits 28 to 18 and Extended ID corresponds to the bits 17 to 0.

When a frame is received by the internal CAN-FD codec, GRCANFD applies the Acceptance filter to decide whether it should be stored into the circular buffer. A frame matches the filter if the following condition is verified:

$$((\text{Received-ID}) \text{ XOR } (\text{ACCPT CODE})) \text{ AND } (\text{ACCPT MASK}) = 0$$

## 26.11.28 Interrupt registers

The interrupt registers give complete freedom to the software, by providing means to mask interrupts, clear interrupts, force interrupts and read interrupt status.

When an interrupt occurs the corresponding bit in the Pending Interrupt Register is set. The normal sequence to initialize and handle a module interrupt is:

- Set up the software interrupt-handler to accept an interrupt from the module.
- Read the Pending Interrupt Register to clear any spurious interrupts.
- Initialize the Interrupt Mask Register, unmasking each bit that should generate the module interrupt.
- When an interrupt occurs, read the Pending Interrupt Status Register in the software interrupt-handler to determine the causes of the interrupt.
- Handle the interrupt, taking into account all causes of the interrupt.
- Clear the handled interrupt using Pending Interrupt Clear Register.

**Masking interrupts:** After reset, all interrupt bits are masked, since the Interrupt Mask Register is zero. To enable generation of a module interrupt for an interrupt bit, set the corresponding bit in the Interrupt Mask Register.

**Clearing interrupts:** All bits of the Pending Interrupt Register are cleared when it is read or when the Pending Interrupt Masked Register is read. Reading the Pending Interrupt Masked Register yields the contents of the Pending Interrupt Register masked with the contents of the Interrupt Mask Register. Selected bits can be cleared by writing ones to the bits that shall be cleared to the Pending Interrupt Clear Register.

**Forcing interrupts:** When the Pending Interrupt Register is written, the resulting value is the original contents of the register logically OR-ed with the write data. This means that writing the register can force (set) an interrupt bit, but never clear it.

**Reading interrupt status:** Reading the Pending Interrupt Status Register yields the same data as a read of the Pending Interrupt Register, but without clearing the contents.

**Reading interrupt status of unmasked bits:** Reading the Pending Interrupt Masked Status Register yields the contents of the Pending Interrupt Register masked with the contents of the Interrupt Mask Register, but without clearing the contents.

The interrupt registers comprise the following:

- Pending Interrupt Masked Status Register[CanPIMSR]R

# LEON3FT Microcontroller

- Pending Interrupt Masked Register[CanPIMR]R
- Pending Interrupt Status Register[CanPISR]R
- Pending Interrupt Register[CanPIR]R/W
- Interrupt Mask Register[CanIMR]R/W
- Pending Interrupt Clear Register[CanPICR]W

Table 275. Interrupt registers

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
											CO Hb Err	CO Syn c	CO Wr cmd	CO Rd cmd	Tx Loss
											0	0	0	0	0
											*	*	*	*	*
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Rx Miss	Tx Err Cntr	Rx Err Cntr	Tx Syn c	Rx Syn c	Tx	Rx	Tx Emp ty	Rx Full	Tx IRQ	Rx IRQ	BM Rd Err	BM Wr Err	OR	Off	Pass
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*

- 20: COHbErr CANOpen Heartbeat Timeout Error
- 19: COSync CANOpen SYNC command received
- 18: COWrCmd CANOpen write command processed
- 17: CORdCmd CANOpen read command processed
- 16: TxLoss Unsuccessful transmission (due to loss of arbitration or errors in the frame)
- 15: RxMiss Message filtered away during reception
- 14: TxErrCntr Transmission error counter incremented
- 13: RxErrCntr Reception error counter incremented
- 12: TxSync Synchronization message transmitted by the codec
- 11: RxSync Synchronization message received by the codec
- 10: Tx Successful transmission of message
- 9: Rx Successful reception of message
- 8: TxEmpty Successful transmission of all frames in TX circular buffer
- 7: RxFull Successful reception of all frames possible to store in RX circular buffer
- 6: TxIRQ The Tx Read Pointer is equal to the value stored in Tx IRQ register
- 5: RxIRQ The Rx Write Pointer is equal to the value stored in Rx IRQ register
- 4: BmRdErr Error during AMBA read access
- 3: BmWrErr Error during AMBA write access
- 2: OR Over-run during reception
- 1: OFF Bus-off condition
- 0: PASS Error-passive condition

All bits in all interrupt registers are reset to 0b after reset.

Note that the BmRdErr interrupt is generated in such way that the corresponding read and write pointers are valid for failure analysis in standard mode. The interrupt generation is independent of the CanCONF.ABORT field setting.

Note that the BmWrErr interrupt is generated in such way that the corresponding read and write pointers are valid for failure analysis in standard mode. The interrupt generation is independent of the CanCONF.ABORT field setting.

# LEON3FT Microcontroller

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GRCANFD is designed following the same approach as GRCAN, but adapting the register interface to the new frame formats and data lengths. This section summarizes the main differences introduced by GRCANFD from the user's point of view:

- While frames in GRCAN were always represented by a single descriptor, FD frames in GRCANFD may require from 1 to 5 descriptors in the circular buffers due to the larger data payload. Whereas the first descriptor of a frame is still compatible, the descriptors 2 to 5 (if applicable) only contain data bytes and do not replicate the bits describing the format of the frame.
- The first descriptor of a frame includes the FDF and BRS bits. These are both set to 0b for classical CAN frames, so it is fully compatible with the memory representation of CAN frames in GRCAN, as these bits were unused.
- The Configuration Register (APB offset 0x000) does not include the CAN timing parameters anymore. Two new registers are created for this purpose: the Nominal Bit-Rate Configuration Register (0x040) and Data Bit-Rate Configuration Register (0x044).
- BPR (Baud Rate) and SAM (Triple Sampling) not supported by GRCANFD. In GRCAN these features may be enabled in the Configuration Register (0x000).
- New control bits to enable the generation of Overload Frames (Receive Channel Control Register, 0x300) and the internal/external loop-back modes (Configuration Register 0x000).
- New Capability Register (0x00C) providing information about the configuration.
- New register for configuring the Transmitter Delay Compensation (0x048). This only applies to the data phase of FD frames (i.e. when switching the bit-rate).
- Since multiple descriptors may be necessary for describing a frame, the interrupts TxIRQ and RxIRQ are asserted when **any** of the descriptors of a transmitted/received frame matches the position programmed via the registers.
- Different device identifier: 0x03D for GRCAN; 0x0B5 for GRCANFD.
- New CANOpen mode. This mode uses a different set of registers. By default the controller operates in standard mode, which is the same general behavior as in GRCAN.

# LEON3FT Microcontroller

## 27 Clock gating unit (Primary)

The GR716 microcontroller have 2 separate clock gating units. Each clock gating unit will control its own clock domains and has a unique AMBA address described in chapter 2.10.

### 27.1 Overview

The clock gating unit provides a mean to save power by disabling the clock to unused functional blocks. The core provides a mechanism to automatically disabling the clock to the LEON processor when it is in power-down mode, and also to disable the clock for the shared floating-point unit. The also core provides a mechanism to reset, enable clock and disable clock for following cores:

- FTMCTRL
- SPI4S
- GRSPWTDP
- GRMEMPROT
- L3STAT
- UART
- AHBUART
- GRPWM
- I2CMST
- I2CSLV
- SPICTRL
- SPIMCTRL
- SPI2AHB
- GRPWRX
- GRPWTX
- SPI2AHB
- I2C2AHB
- NVRAM
- APWMCTRL
- ACOMP
- GPIO

The core provides a register interface via its APB slave bus interface.

### 27.2 Operation

The operation of the clock gating unit is controlled through four registers: the unlock, clock enable, core reset and CPU/FPU override registers. The clock enable register defines if a clock is enabled or disabled. A '1' in a bit location will enable the corresponding clock, while a '0' will disable the clock. The core reset register allows to generate a reset signal for each generated clock. A reset will be generated as long as the corresponding bit is set to '1'. The bits in clock enable and core reset registers can only be written when the corresponding bit in the unlock register is 1. If a bit in the unlock register is 0, the corresponding bits in the clock enable and core reset registers cannot be written.

To gate the clock for a core, the following procedure should be applied:

1. Disable the core through software to make sure it does not initialize any AHB accesses

# LEON3FT Microcontroller

2. Write a 1 to the corresponding bit in the unlock register
3. Write a 0 to the corresponding bit in the clock enable register
4. Write a 0 to the corresponding bit in the unlock register

To enable the clock for a core, the following procedure should be applied

1. Write a 1 to the corresponding bit in the unlock register
2. Write a 1 to the corresponding bit in the core reset register
3. Write a 1 to the corresponding bit in the clock enable register
4. Write a 0 to the corresponding bit in the clock enable register
5. Write a 0 to the corresponding bit in the core reset register
6. Write a 1 to the corresponding bit in the clock enable register
7. Write a 0 to the corresponding bit in the unlock register

The clock gating unit also provides gating for the processor core and floating-point unit. The processor core will be automatically gated off when it enters power-down mode.

The FPU will be gated off when the LEON3FT processor core connected to the FPU have floating-point disabled or when the LEON3FT processor core is in power-down mode.

Processor/FPU clock gating can be disabled by writing '1' to bit 0 of the CPU/FPU override register.

## 27.3 Registers

The core's registers are mapped into APB address space.

Table 276. Clock gate unit registers

APB address offset	Register
0x00	Unlock register 0
0x04	Clock enable register 0
0x08	Core reset register 0
0x0C	CPU/FPU override register 0
0x10 - 0xFF	Reserved

### 27.3.1 Unlock register 0

Table 277. 0x00 - UNLOCK1 - Unlock register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
G0	NV	SP	TD	AS	MP	AU	L3	R	R	H5	U4	U3	U2	U1	U0	P1	P0	DA	IS1	IS0	IM1	IM0	S1	S0	M1	M0	MC	PX	PR	IA	SA
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w

31: 0      Unlock clock enable and reset registers (UNLOCK) - The bits in clock enable and core reset registers can only be written when the corresponding bit in this field is 1. See Table 278 for bit field description



# LEON3FT Microcontroller

## 27.3.2 Clock enable register 0

Table 278.0x04 - CLKEN0 - Clock enable register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
G0	NV	SP	TD	R	MP	AU	L3	AP	R	H5	U4	U3	U2	U1	U0	R	CD	AC	IS1	IS0	IM1	IM0	S1	S0	M1	M0	MC	PX	PR	IA	SA
0	*	0**	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	*	*	0	0	*	*	*	0	0	*	*
r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w

\* Reset value depends on bootstrap signals.

\*\* Bit field may be set to 1 by boot SW during startup of the device.

31: 0 Clock enable - A '1' in a bit location will enable the corresponding clock, while a '0' will disable the clock.

- 31 Clock enable GPIO0 (G0)
- 30 Clock Enable NVRAM (NV)
- 29 Clock enable SPI4S (SP)
- 28 Clock enable GRSPWTD (TD)
- 27 RESERVED (TBC)
- 26 Clock enable MEMPROT (MP)
- 25 Clock enable AHBUART (AU)
- 24 Clock enable L3STAT (L3)
- 23 Clock enable APWMCTRL (AP) (TBC)
- 22 RESERVED
- 21 Clock enable APBUART5 (U5)
- 20 Clock enable APBUART4 (U4)
- 19 Clock enable APBUART3 (U3)
- 18 Clock enable APBUART2 (U2)
- 17 Clock enable APBUART1 (U1)
- 16 Clock enable APBUART0 (U0)
- 15 RESERVED (TBC)
- 14 Clock enable CLKDET (CD) (TBC)
- 13 Clock enable ACOMP (AC) (TBC)
- 12 Clock enable I2CLSV1 (IS1)
- 11 Clock enable I2CLSV0 (IS0)
- 10 Clock enable I2CMST1 (IM1) (TBC)
- 9 Clock enable I2CMST0 (IM0) (TBC)
- 8 Clock enable SPICTRL1 (S1)
- 7 Clock enable SPICTRL0 (S0)
- 6 Clock enable SPIMCTRL1 (M1)
- 5 Clock enable SPIMCTRL0 (M0)
- 4 Clock enable FTMCTRL (MC)
- 3 Clock enable GRPWTX (PX)
- 2 Clock enable GRPWRX (PR)
- 1 Clock enable I2C2AHB (IA)
- 0 Clock enable SPI2AHB (SA)

# LEON3FT Microcontroller

## 27.3.3 Core reset register 0

Table 279. 0x08 - RESET0 - Reset register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
G0	NV	SP	TD	AS	MP	AU	L3	ID	R	H5	U4	U3	U2	U1	U0	P1	P0	DA	IS1	IS0	IM1	IM0	S1	S0	M1	M0	MC	PX	PR	IA	SA	
*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*
r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	r/w	

31: 0      Reset (RESET) - A reset will be generated as long as the corresponding bit is set to '1'. See Table 278 for bit field description. The reset value for each bit is the inverse of the reset value of the corresponding bit in the CLKEN0 register.

## 27.3.4 CPU/FPU override register 0

Table 280. 0x0c - OVERRIDE0 - CPU/FPU override register 0

31																17	16	15																1	0			
RESERVED																	FOVERRIDE			RESERVED																	OVERRIDE	
0																	0			0																	0	
r																	r/w			r																	r/w	

31: 17      RESERVED

16      Override FPU clock gating (FOVERRIDE) - If bit n of this field is set to '1' then the clock for FPU n will be active regardless of the value of %PSR.EF.

15: 1      RESERVED

0      Override CPU clock gating (OVERRIDE) - If bit n of this field is set to '1' then the clock for the processor and FPU will always be active.

# LEON3FT Microcontroller

## 28 Clock gating unit (Secondary)

The GR716 microcontroller have 2 separate clock gating units. Each clock gating unit will control its own clock domains and has a unique AMBA address described in chapter 2.10.

### 28.1 Overview

The clock gating unit provides a mean to save power by disabling the clock to unused functional blocks. The core provides a mechanism to reset, enable clock and disable clock for following cores:

- GRDMAC2
- GR1553B
- GRCANFD
- GRSPWROUTER
- ADC
- DAC
- RTA
- APWM
- ACOMP
- FIR
- APWMDAC
- GPTIMER
- GPIO
- GRSEQ
- GRSCRUB

The core provides a register interface via its APB slave bus interface.

### 28.2 Operation

The operation of the secondary clock gating unit is controlled through three registers: the unlock, clock enable and core reset registers. The clock enable register defines if a clock is enabled or disabled. A '1' in a bit location will enable the corresponding clock, while a '0' will disable the clock. The core reset register allows to generate a reset signal for each generated clock. A reset will be generated as long as the corresponding bit is set to '1'. The bits in clock enable and core reset registers can only be written when the corresponding bit in the unlock register is 1. If a bit in the unlock register is 0, the corresponding bits in the clock enable and core reset registers cannot be written.

To gate the clock for a core, the following procedure should be applied:

1. Disable the core through software to make sure it does not initialize any AHB accesses
2. Write a 1 to the corresponding bit in the unlock register
3. Write a 0 to the corresponding bit in the clock enable register
4. Write a 0 to the corresponding bit in the unlock register

To enable the clock for a core, the following procedure should be applied

1. Write a 1 to the corresponding bit in the unlock register
2. Write a 1 to the corresponding bit in the core reset register
3. Write a 1 to the corresponding bit in the clock enable register
4. Write a 0 to the corresponding bit in the clock enable register

# LEON3FT Microcontroller

5. Write a 0 to the corresponding bit in the core reset register
6. Write a 1 to the corresponding bit in the clock enable register
7. Write a 0 to the corresponding bit in the unlock register

## 28.3 Registers

The core’s registers are mapped into APB address space.

Table 281. Clock gate unit registers

APB address offset	Register
0x00	Unlock register 1
0x04	Clock enable register 1
0x08	Core reset register 1
0x0C - 0xFF	Reserved

### 28.3.1 Unlock register 1

Table 282. 0x00 - UNLOCK1 - Unlock register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
G1	T1	FR	D8	D7	D6	D5	AP	R1	R0	S1	S0	R	R	R	R	A3	A2	A1	A0	D3	D2	D1	D0	SP	LV	C0	ML	GR	AP	D1	D0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

31: 0      Unlock clock enable and reset registers (UNLOCK) - The bits in clock enable and core reset registers can only be written when the corresponding bit in this field is 1. See Table 283 for bit field description

# LEON3FT Microcontroller

## 28.3.2 Clock enable register 1

Table 283.0x04 - CLKEN1 - Clock enable register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
G1	T1	FR	D7	D6	D5	D4	S1	S0	SC	RESERVED						A3	A2	A1	A0	D3	D2	D1	D0	SP	LV	C0	ML	GR	AP	D1	D0	
0	0	0	0	0	0	0	0	0	0	0						0	0	0	0	0	0	0	0	0	*	0	*	0	0	0	0	0
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw						rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

\* The reset value of this bit depends on bootstrap signals.

31: 0 Clock enable - A '1' in a bit location will enable the corresponding clock, while a '0' will disable the clock.

- 31 Clock enable GPIO1 (G1)
- 20 Clock enable GPTIMER1 (T1)
- 29 Clock enable FIR (FR) (TBD)
- 28 Clock enable APWMDAC3 (D7)
- 27 Clock enable APWMDAC2 (D6)
- 26 Clock enable APWMDAC1 (D5)
- 25 Clock enable APWMDAC0 (D4)
- 24 Clock enable GRSEQ1 (S1)
- 23 Clock enable GRSEQ0 (S0)
- 22 Clock enable GRSCRUB (SC) (TBC)
- 21: 16 RESERVED (TBC)
- 15 Clock enable ADC3 (A3)
- 14 Clock enable ADC2 (A2)
- 13 Clock enable ADC1 (A1)
- 12 Clock enable ADC0 (A0)
- 11 Clock enable DAC3 (D3)
- 10 Clock enable DAC2 (D2)
- 9 Clock enable DAC1 (D1)
- 8 Clock enable DAC0 (D0)
- 7 Clock enable GRSPWROUTER (SP)
- 6 Clock enable LVDSIO Control (LV)
- 5 Clock enable GRCAN0 (C0)
- 4 Clock enable GR1553B (ML)
- 3 Clock enable GRETH (GR)
- 2 Clock enable APWM (AP)
- 1 Clock enable GRDMAC (D1)
- 0 Clock enable GRDMAC (D0)

# LEON3FT Microcontroller

## 28.3.3 Core reset register 1

Table 284. 0x08 - RESET1 - Reset register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
G1	T1	FR	D8	D7	D6	D5	AP	R1	R0	S1	S0	R	R	R	R	A3	A2	A1	A0	D3	D2	D1	D0	SP	LV	C0	ML	GR	AP	D1	D0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

31: 0                      Reset (RESET) - A reset will be generated as long as the corresponding bit is set to '1'. See Table 283 for bit field description

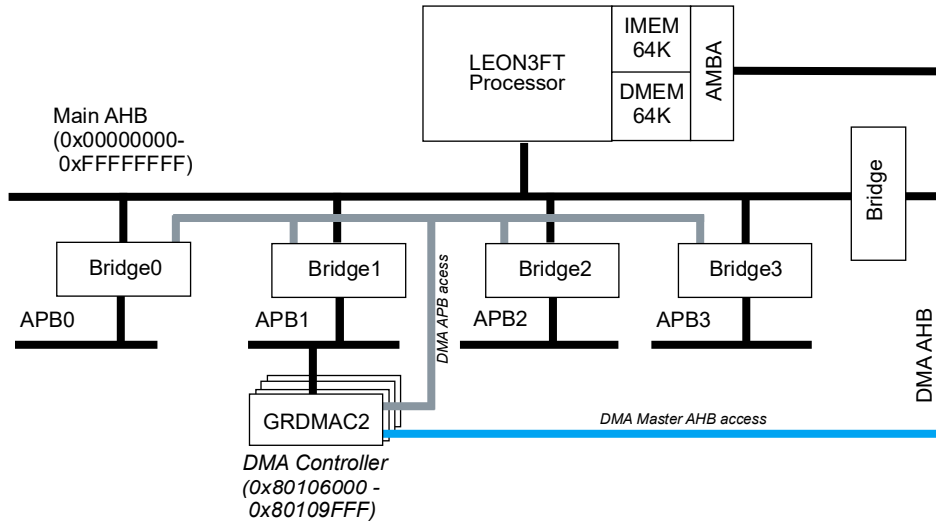
# LEON3FT Microcontroller

## 29 Direct Memory Access Controller

The GR716B microcontroller comprises 2 separate DMA controller with internal AHB/APB bridge units (GRDMAC2). The GRDMAC2 units described in this section provides a flexible direct memory access controller. The core can perform burst transfers of data between AHB and APB peripherals at aligned or unaligned memory addresses.

The control and status register for the DMA controller units are located on APB bus in the address range from 0x80106000 to 0x80109FFF. See DMA controller units connections in the next drawing. The drawing picture memory locations and bus connections used for DMA controller units.

Figure 54. GR716B GRDMACB bus connection



The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the individual DMA controller units. The unit **GRCLKGATE** can also be used to perform reset of individual DMA controller units. Software must enable clock and release reset described in section 27 before configuration.

The system can be configured to protect and restrict access to DMA controller units.

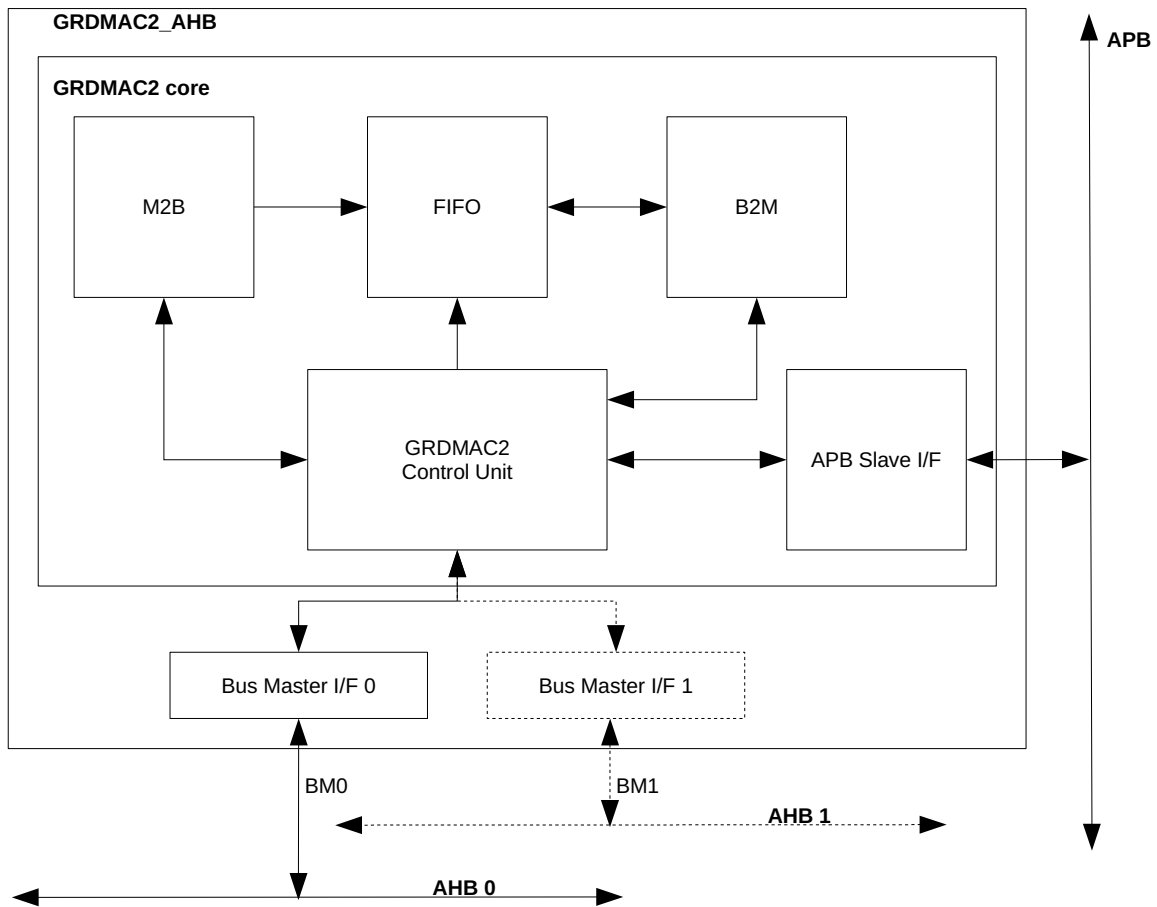
### 29.1 Overview

GRDMAC2 is a flexible direct memory access controller with Bus Master Interface. The basic building blocks of GRDMAC2 are a control module, internal buffer, memory to buffer operation module(M2B), buffer to memory operation module(B2M) and a wrapper layer which provides Bus Master Interface integration and APB register configuration interface. GRDMAC2 can perform burst transfers of data between AHB and APB peripherals at aligned or unaligned memory addresses. Each GRDMAC2 have two Bus Master Interfaces to perform transfers among different AHB buses, therefore GRDMAC2 has a bridging capability.

GRDMAC2 works with self contained descriptors, with all information needed for the DMA transaction. Descriptor configuration allows specification of source and destination addresses which allows a scatter/gather behavior. GRDMAC2 allows multiple types of descriptors which can be broadly classified as data descriptor and conditional descriptor. This enables GRDMAC2 to perform regular data transfer as well as perform an action on occurrence of a specific condition. Conditional descriptors allows an if-else mode of execution based on the condition check outcome. Figure below depicts the

# LEON3FT Microcontroller

basic block diagram of GRDMAC2. The diagram assumes that the AHB wrapper is used, but the functionality is equivalent if the bus master or the AXI wrapper are chosen instead.



With the flexible descriptor queue with conditional descriptors and data descriptors, GRDMAC2 can be used with peripherals like APBUART and other controllers like SPI controller. A typical use case example of GRDMAC2 is described in section 29.6.

GRDMAC2 is equipped with multiple error flags for different kinds of error events and eight individual APB registers solely for debug capability of the current descriptor that is being executed. GRDMAC2 always displays the current execution state in status register and freezes this display in case of an error to make debugging easy.

## 29.2 Operation

### 29.2.1 Operation overview

When GRDMAC2 execution is enabled by the user by setting 'EN' bit in the APB control register, descriptor execution starts from the first descriptor which is pointed by Descriptor Pointer APB Register. GRDMAC2 reads descriptor configurations from any AHB mapped address (typically main memory) through its main Bus Master Interface (BM0 if instantiated with support for two Bus Master Interfaces).

GRDMAC2 decodes the descriptor configuration, identifies the type of descriptor and continues with execution procedure specific to the current descriptor type. On completion of each of the descriptor, GRDMAC2 writes back the status to the descriptor status word, if 'wb' bit is enabled in the descriptor. Execution continues with the next descriptor pointer by the current descriptor's next descriptor pointer field. In the case of a failed conditional descriptor, DMA controller selects address,



pointed by '*fnext.addr*' field, to fetch next descriptor. Fetch-Decode-Execute procedure is performed on each enabled descriptor in the descriptor queue. Any disabled descriptor in the queue is simply skipped and the DMA controller continues execution with the next enabled descriptor in the queue. Descriptor queue should be set up such that the last descriptor in the queue should have '*next.last*' bit value as 1. GRDMAC2 continues execution until it encounters a last descriptor. After completing the last descriptor execution successfully, GRDMAC2 marks the execution status as 'Completed' in the status register and stays idle.

Bus master interface index to be selected for conditional descriptor execution is determined by '*bm*' field in descriptor control word. GRDMAC2 allows the selection of individual Bus Master Interface index for source and destination in data descriptors. Descriptor fetches from the memory and write back to the descriptor status word in the memory is performed through default Bus Master Interface, irrespective of the type of descriptor.

The functionalities supported by GRDMAC2 for DMA operation is described in the following sections.

#### 29.2.1.1 Pause and resume

When DMA controller has started processing the descriptors in the current descriptor queue, it is possible to pause the execution in between. Clearing the '*EN*' bit in GRDMAC2 control register(CTRL) will pause the descriptor queue processing. However, execution will pause only after successfully completing the current descriptor execution. GRDMAC2 sets the '*PAU*' bit as 1, and clears the '*ONG*' bit in the status register. Once paused, GRDMAC2 stays idle until '*EN*' and '*KICK*' bit is set in the CTRL register. Once the paused GRDMAC2 is enabled again and kicked by the user, execution resumes from the next descriptor in the queue, if there are enabled descriptors in the remaining part of queue.

#### 29.2.1.2 Restart

GRDMAC2 restarts current descriptor queue execution when '*RT*' bit is set in GRDMAC2 control register (CTRL). Restarting the descriptor queue execution will be performed only after completing the current descriptor execution. DMA controller restarts execution from the first descriptor pointed by Descriptor Pointer APB Register. When '*RT*' bit is set by the user when a descriptor processing is in progress, the request is acknowledged and '*RSP*' bit is set in GRDMAC2 status register. This self clearing bit is cleared by GRDMAC2 when the descriptor queue execution is restarted after the current descriptor is executed completely.

#### 29.2.1.3 Descriptor queue management

GRDMAC2 allows the modification of descriptor queue even after the DMA has started processing the current descriptor queue. Only appending new descriptors are allowed. In order to append new descriptor at the end of descriptor queue, user need to clear '*next.last*' bit of the last descriptor in the current queue and point to the new descriptor as the next descriptor. Mark the new descriptor as the last one. Adding multiple new descriptors also have the same procedure apart from the fact that the last descriptor will be at the end of the newly added part of the queue. Once the descriptor queue is modified, it is mandatory to kick GRDMAC2 to indicate the presence of modified descriptor queue. DMA controller acknowledges kick by setting '*KP*' bit in GRDMAC2 status register. '*KP*' bit is cleared by GRDMAC2 when a new descriptor is taken up for execution. Any type of descriptor queue modification other than appending at the end of the current descriptor queue, is illegal.

#### 29.2.1.4 Reset

Setting '*RST*' bit in GRDMAC2 control register(CTRL) resets the DMA controller, canceling any ongoing descriptor execution. The reset clears all the register fields to their default values.

### 29.2.2 Data descriptor execution

During a standard data descriptor execution, GRDMAC2 will perform two types of DMA transfers through one of the Bus Master Interfaces: from memory to the internal buffer (M2B) and from the internal buffer to memory (B2M). GRDMAC2 splits the total size of data to be transferred for a data descriptor, into data chunks of size equal to minimum of the following factors. Size of the internal buffer, maximum burst length or a maximum of 1024 bytes.

After fixing the size of each burst, the DMA controller transfers data chunks from source to destination through M2B and B2M operations. A chunk of data is transferred from memory to the internal buffer as part of the M2B operation and M2B operation is paused. Execution control is switched to B2M operation, where the DMA controller transfers the data chunk from the internal buffer to the destination memory and pauses B2M operation. GRDMAC2 then switches back to the M2B operation which was paused earlier and repeats the same process for the next chunk of data. M2B-B2M cycles are repeated until the total size of data transfer is completed and descriptor is marked as completed. On descriptor completion, based on whether 'wb' bit is enabled in the descriptor control word, status of the descriptor execution is written back to the descriptor status word.

Data is transferred between source address and destination address which are configured in the descriptor. The offset of source address from which data is fetched is determined by the bit field 'src\_fixed\_addr' in the descriptor control word. Similarly the offset of destination address to which data is written is determined by the bit field 'dest\_fixed\_addr' in the descriptor control word. If src\_fixed\_addr field is set to 1, GRDMAC2 always fetches data from the same source address. Similarly if 'dest\_fixed\_addr' field is set to 1, GRDMAC2 always writes to the same destination address. If any of these fields are not set to 1, GRDMAC2 automatically considers incrementing offsets for source/destination addresses for data read/write. In short, GRDMAC2 can perform burst transactions in the following ways based on the different configurations of 'src\_fixed\_addr' and 'dest\_fixed\_addr' fields:

1. Data fetched from incrementing source address offsets, written to incrementing destination address offsets.
2. Data fetched from incrementing source address offsets, written to fixed destination address.
3. Data fetched from fixed source address, written to incrementing destination address offsets.
4. Data fetched from fixed source address, written to fixed destination address.

M2B and B2M operation can be performed through the same or different Bus Master Interface index. This selection is performed by configuring 'srcbm' and 'dstbm' in descriptor control word provided that second Bus Master Interface.

- **Data descriptor execution example**

Steps of a data descriptor execution example is given below.

- a) GRDMAC2 starts M2B operation.
- b) GRDMAC2 checks size of data to be transferred between source and destination for descriptor completion. GRDMAC2 compares the size of internal buffer, maximum burst length and maximum boundary of 1024 bytes and finds out the current burst size.
- c) A read burst initiated on the selected Bus Master Interface transfers data from source memory address (incrementing offsets if 'src\_fid\_addr' field is not set.) to GRDMAC2 internal buffer. If 'src\_fid\_addr' field is set in the descriptor, data is always read from the same source address.
- d) GRDMAC2 checks if there is data yet to be fetched from source to complete the descriptor execution. If yes goes to step e. Otherwise goes to step f.
- e) GRDMAC2 pauses M2B operation and switches to B2M operation. Goes to step g.
- f) GRDMAC2 completes M2B operation and Switches to B2M operation. Goes to step g.
- g) GRDMAC2 checks size of data to be transferred between source and destination for descriptor completion. GRDMAC2 compares the size of internal buffer, maximum burst length and maximum

boundary of 1024 bytes and finds out the current burst size.

**h)** A write burst is initiated on the selected Bus Master Interface transfers data from GRDMAC2 internal buffer to destination memory address(incrementing offsets if *'dest\_fix\_addr'* field is not set).

If *'dest\_fix\_addr'* field is set in the descriptor, data is always written to the same destination address.

**i)** GRDMAC2 checks if there is data yet to be written to destination in order to complete the descriptor execution. If yes goes to step **j**. Otherwise goes to step **k**.

**j)** GRDMAC2 pauses B2M operation and switches to M2B operation. Goes to step **b**.

**k)** GRDMAC2 completes B2M operation. Mark descriptor as completed.

**l)** Writes back the execution status to descriptor status word, if *'wb'* bit is enabled in the descriptor control word.

**m)** Fetches the next descriptor (pointed by *'next\_addr'*) in the queue if there are any. On the other hand, if the current descriptor is the last, marks the execution completion in GRDMAC2 status register.

### 29.2.3 Conditional descriptor execution

A conditional descriptor is a special kind of descriptor which can be executed to perform a task with conditional behavior. A conditional descriptor can be used to create a DMA transfer that retrieves data from IO cores, therefore off loading the CPU from the task. Usually IO cores provide a status register or an interrupt line to notify the CPU of the availability of new data. A conditional descriptor can be set up to poll this status register or to be triggered by an interrupt, signaling for instance, the availability of new data. This is a typical use case of conditional descriptor execution.

GRDMAC2 identifies a conditional descriptor from the *'type'* field in the descriptor control word. Current version of GRDMAC2 supports 3 types of conditional descriptors. Polling type(*'type'* = 1), Triggering type(*'type'* = 2) and Poll-on-trigger type(*'type'* = 3). The field *'bm'* in descriptor control word, decides the Bus Master Interface index which performs memory accesses during conditional descriptor execution.

Conditional descriptor *'next\_addr'* field points to the next descriptor's control word address.

Setting *'next.last'* bit marks the current descriptor as the last descriptor in the descriptor queue.

Conditional descriptors allows an 'if-else' method of condition check by *'next'* and *'fnext'* fields. On successful execution of a conditional descriptor, GRDMAC2 execution control continues to *'next\_addr'* as long as the *'next.last'* bit is not set. On the other hand, if the conditional descriptor execution was failed, execution continues with the next descriptor pointed by *'fnext'*. It is mandatory that *'fnext.last'* bit is never set. Setting this bit will result in a decode descriptor error and *'DE'* will be set in GRDMAC2 status register. This applies to all types of conditional descriptors.

Conditional descriptor fields like *'poll\_addr'*, *'expd.data'* and *'cond.mask'* are relevant only for polling or Poll-on-trigger type of descriptors.

#### 29.2.3.1 Polling descriptor execution

A polling type descriptor should have *'ctrl.type'* field value 1 in descriptor control word. During a polling descriptor execution, GRDMAC2 polls the address configured in *'poll\_addr'* field. Polling is performed in specific number of clock cycle intervals. Interval between polling accesses is decided by *'intrv'* field in descriptor control word. Setting interval between each poll access avoids holding the bus and makes the bus available for other cores in the system.

Polling result data is compared with expected data value configured in *'expd.data'* descriptor field and conditional mask for comparison configured in *'cond.mask'* descriptor field to evaluate the success of the conditional descriptor execution. Condition check is performed as follows.

Table 285. Condition for successful polling descriptor execution

(Content of <i>'poll_addr'</i> ) AND <i>'cond.mask'</i> = <i>'expd.data'</i> AND <i>'cond.mask'</i>
---

In other words, the polling result and expected data is compared only on the bit positions that are set in the conditional mask field. After each polling, condition is checked and this polling-condition check process is repeated for specific number of times based on the value configured in 'count' field in descriptor control word. If the condition check is not successful even after repeating the polling-condition check process 'count' times, polling descriptor execution will have a failed status. Otherwise if the condition check was successful before 'count' times, the polling descriptor execution will be completed successfully.

Apart from the iteration limit on Polling and condition check process, polling descriptor execution is bound by a timeout mechanism if timeout check is enabled in GRDMAC2 control register(CTRL) and during controller instantiation. GRDMAC2 waits for number of clock cycles specified in APB register 'TRST'(Timer reset value register) before generating a timeout status. Timeout is interpreted either as a failed execution or as an error, based on the field 'errto' in descriptor control word. Setting 'ctrl.errto', treats timeout as an error and a failed condition otherwise. On successful condition check, GRDMAC2 marks the descriptor as completed and moves on with the next descriptor execution if there are any present. If the polling descriptor execution is failed, GRDMAC2 fetches next descriptor from address pointed by 'fnext.addr' descriptor field and continues execution.

- **Polling descriptor execution example**

Steps of a polling descriptor example is given below. A counter is decremented from reset value as soon as the polling descriptor execution has started. Reset value of this counter can be configured through GRDMAC2 'TRST' register.

- a) GRDMAC2 checks if timeout counter value is zero. If yes, Goes to step **i**. Goes to step **c** otherwise
- b) GRDMAC2 polls memory address configured in 'poll.addr'. Starts incrementing counter(C0) which increments every clock cycle. Goes to step **d**.
- c) Clears the counter C0. Goes to step **b**.
- d) Increment a polling iteration count by 1. Goes to step **e**.
- e) GRDMAC2 compares the read data with 'expd.data' and 'cond.mask' based on condition in table 285. If condition check is successful, Goes to step **h**. If the condition check is unsuccessful goes to step **f**.
- f) GRDMAC2 checks if polling iteration count is equal to 'count' configured in descriptor control word. If yes goes to step **k**, else goes to step **g**.
- g) Checks if the counter (C0) value is equal to 'intrv' configured in descriptor control word. If yes goes to step **a**, else goes to step **g**.
- h) Marks descriptor as completed. Writes back the execution status to descriptor status word, if 'wb' bit is enabled in the descriptor control word. Goes to step **j**.
- i) Marks timeout. If 'errto' field is set in the descriptor control word, marks error bit 'ERR' and 'PE' bit in GRDMAC2 status register and stop ongoing execution. If 'errto' field is not set in the descriptor control word, goes to step **k**.
- j) Fetches the next descriptor(pointed by 'next.addr') in the queue if there are any. On the other hand, if the current descriptor is the last, marks the execution completion in GRDMAC2 status register.
- k) Writes back descriptor status if 'wb' bit is enabled in the descriptor control word. Fetches the next descriptor pointed by 'fnext.addr' and continue execution.

### 29.2.3.2 Triggering descriptor execution

A triggering type descriptor must have 'type' field value 2 in descriptor control word. Triggering descriptor monitors the input trigger on the interrupt line specified in the field 'irqn' in the descriptor control word. If the timeout mechanism is enabled, the descriptor execution continues the process of monitoring for input trigger, either till the expected trigger is received or till timeout. Based on the 'errto' bit field in the control word of a triggering descriptor, timeout is treated either as an error or as a failed descriptor execution status.

## LEON3FT Microcontroller

On successful execution of triggering descriptor, GRDMAC2 marks the descriptor as completed and moves

on with the next descriptor execution if there are any present. If triggering descriptor execution is failed, GRDMAC2 fetches next descriptor from address pointed by *fnext.addr* descriptor field and continues execution.

The expected trigger event type is configured by *ctrl.trtp* field and *poll.trig\_val* field in the descriptor. Setting *ctrl.trtp* field to 1 in the descriptor will configure the expected event as level and clearing *ctrl.trtp* field will configure the expected event as edge. Setting *poll.trig\_val* field to 1 in the descriptor will configure the expected event as a negative edge/

low level(based on the *ctrl.trtp* value). Clearing *poll.trig\_val* field in the descriptor will configure the expected event as a positive edge/high level(based on the *ctrl.trtp* value).

- **Triggering descriptor execution example**

Steps of a triggering descriptor example is given below. A counter is decremented from reset value as soon as the triggering descriptor execution has started. Reset value of this counter can be configured through GRDMAC2 *TRST* register.

- a) GRDMAC2 checks if timeout counter value is zero. If yes, Goes to step e. Goes to step b otherwise.
- b) GRDMAC2 monitors the interrupt line number *irqn* configured in descriptor control word for expected event.
- c) If expected event occurs, goes to step d, else goes to step a.
- d) Marks descriptor as completed. Writes back the execution status to descriptor status word, if *wb* bit is enabled in the descriptor control word. Goes to step f.
- e) Marks timeout. If *errto* field is set in the descriptor control word, Marks error bit *ERR* and *PE* bit in GRDMAC2 status register and stop ongoing execution. If *errto* field is not set in the descriptor control word, goes to step k.
- f) Fetches the next descriptor (pointed by *next.addr*) in the queue if there are any. On the other hand, if the current descriptor is the last, marks the execution completion in GRDMAC2 status register.
- g) Writes back descriptor status if *wb* bit is enabled in the descriptor control word. Fetches the next descriptor pointed by *fnext.addr* and continue execution.

### 29.2.3.3 Poll-on-trigger descriptor execution

A poll-on-trigger type descriptor must have *ctrl.type* field value 3 in descriptor control word. Poll-on-trigger type descriptor execution combines the functionality of a triggering descriptor and a polling descriptor. Poll-on-trigger type of descriptor execution monitors the input trigger on the interrupt line specified in the field *irqn* in the descriptor control word. On reception of the expected trigger on IRQ line of interest, GRDMAC2 polls the address configured in *poll.addr* field. Each polling access is separated by *intrv* number of clock cycle as configured in descriptor control word. After each polling the result(content of *poll.addr* address) is compared with expected data(*expd.data*) and mask(*cond.mask*) using the condition described in table 285. Polling and condition check process is repeated for *count* times as configured in the descriptor control word. Both trigger monitoring and polling are individually bound by timeout if timeout mechanism is enabled.

On successful execution of poll-on-trigger descriptor, GRDMAC2 marks the descriptor as completed and moves on with the next descriptor execution if there are any present. If poll-on-trigger descriptor execution is failed, GRDMAC2 fetches next descriptor from address pointed by *fnext.addr* descriptor field and continues execution.

## 29.3 Configuration

The DMA controller and descriptors should be configured properly for successful operation of the controller. The following sections describes the DMA controller and descriptor configuration in detail.

## 29.3.1 GRDMAC2 configuration

GRDMAC2 can be configured through APB register interface. The following APB registers should be used to configure DMA controller.

- **Control register (CTRL)**

Control register allows the configuration of interrupt generation on error and descriptor completion. Control register also allows the user to enable timeout mechanism for conditional descriptors. Timeout mechanism for conditional descriptors can be enabled by setting 'TE' bit in control register. Conditional descriptor execution is bound by timeout if timeout mechanism is enabled. Conditional descriptor execution will continue for ever or until the successful condition check result if timeout is disabled.

There are designated bits which allows different functionalities like kicking, enabling, resetting, pausing and restarting GRDMAC2. These functionalities are explained in section 29.2.1, in detail.

- **Timer reset value register (TRST)**

Configuring TRST register has an impact only on the conditional descriptor execution, provided that timeout mechanism is enabled. During a conditional descriptor execution, GRDMAC2 will wait for, number of clock cycles configured in Timer reset value register, before generating a timeout status.

- **First descriptor pointer (FPTR)**

First descriptor pointer register should be configured to point to the first descriptor in a descriptor queue.

## 29.3.2 Descriptor configuration

Descriptor types supported by GRDMAC2 can be broadly classified as data and conditional descriptors. Conditional descriptors are further classified based on the type of condition check they are trying to satisfy. GRDMAC2 demands pre-defined descriptor configuration for each of these types, as described in sections 29.3.2.1 and 29.3.2.2. It is mandatory that descriptors are written to two byte aligned addresses in the memory. By default, Bus Master Interface index 0 is selected for all descriptor reading and execution status write back.

### 29.3.2.1 Data descriptor format

Data descriptor format and description of individual fields are displayed below.

Table 286. Data descriptor format

Address offset	Field
0x00	Control word
0x04	Next descriptor pointer
0x08	Destination base address
0x0C	Source base address
0x10	Status word

# LEON3FT Microcontroller

Table 287. 0x00 - ctrl - Data descriptor control word

31	11	10	9	8	7	6	5	4	1	0
size	destfix	srcfix	irqe	dstbm	srcbm	wb	type	en		
31 : 11	size	Total size of data to be transferred from source to destination.								
10	destfix	All data is to be written to the same(fixed) destination address 0- Non fixed destination address(incrementing address offsets) 1- Fixed destination address								
9	srcfix	All data is to be read from the same(fixed) source address 0- Non fixed source address(incrementing address offsets) 1- Fixed source address								
8	irqe	Enable interrupt on descriptor completion 0- Disable interrupt 1 - Enable interrupt								
7	dstbm	Bus master interface index through which data is to be written to the destination. 0 - BM0 1 - BM1								
6	srcbm	Bus master interface index through which data is to be read from the source. 0 - BM0 1 - BM1								
5	wb	Write back status to current descriptor status word, after execution. 0- disable write back 1- enable write back								
4 : 1	type	Descriptor type. 0- data descriptor								
0	en	Enabled data descriptor. 0- Disabled 1- Enabled								

Table 288.0x04 - next - Next descriptor pointer

31			1	0
addr			last	
31 : 1	addr	MSB of 2 byte aligned next descriptor start address.		
0	last	Last descriptor in the descriptor queue. 0 - Not last descriptor 1 - Last descriptor		

Table 289.0x08 - dest - Destination base address

31			0
addr			
31 : 0	addr	Destination base address to which data is to be written.	

# LEON3FT Microcontroller

Table 290. 0x0C - src - Source base address

31	0	
addr		
31 : 0	addr	Source base address to which data is to be written.

Table 291. 0x10 - sts - Descriptor status word

31	2	1	0
Reserved			err done
31 : 2	Reserved		
1	err	Descriptor execution error status. 0 - No error. 1 - Error during execution	
0	done	Descriptor completion without error. 0 - Not completed 1 - Completed	

### 29.3.2.2 Conditional descriptor format

Conditional descriptor format and description of individual fields are displayed below.

Table 292. Conditional descriptor format

Address offset	Field
0x00	Control word
0x04	Next descriptor pointer
0x08	Next descriptor pointer on failure
0x0C	Polling address
0x10	Status word
0x14	Expected data
0x18	Conditional mask



# LEON3FT Microcontroller

Table 293. 0x00 - ctrl - Conditional descriptor control word

31	24	23	16	15	14	13	12	7	6	5	4	1	0
count		intrv		trtp	irqe	errto	irqn	bm	wb	type		en	
31 : 24		count		Number of time the polling and condition check to be repeated before assuming a failed execution status									
23 : 16		intrv		Number of clock cycle interval between consecutive polling accesses.									
15		trtp		Type of input trigger event expected. 0- Edge 1- Level									
14		irqe		Enable interrupt on descriptor completion 0- Disable interrupt 1 – Enable interrupt									
13		errto		Timeout is to be treated as an error or a failed conditional descriptor execution. 0 - Timeout is a failed conditional descriptor execution, 1 - Timeout is an error.									
12 : 7		irqn		Interrupt line number to be monitored for input trigger, if the current descriptor is a triggering/poll-on-trigger descriptor.									
6		bm		Bus master interface index through which polling accesses are to be performed, if the current descriptor is a polling descriptor. 0 – BM0 1 - BM1									
5		wb		Write back status to current descriptor status word, after execution. 0- disable write back 1- enable write back									
4 : 1		type		Descriptor type. 1- Polling 2- Triggering 3- Poll-on-trigger									
0		en		Enabled data descriptor. 0- Disabled 1- Enabled									

Table 294. 0x04 - next - Next descriptor pointer

31			1	0
addr			last	
31 : 1	addr		MSB of 2 byte aligned next descriptor start address. This pointer will be considered for execution when current conditional descriptor has executed successfully.	
0	last		Last descriptor in the descriptor queue. 0 - Not last descriptor 1 - Last descriptor	

# LEON3FT Microcontroller

Table 295. 0x08 - fnext - Next descriptor pointer on failure

31			1	0
addr			last	
31 : 1	addr	MSB of 2 byte aligned next descriptor start address. This pointer will be considered for execution when current conditional descriptor has failed.		
0	last*	Last descriptor in the descriptor queue. 0 - Not last descriptor		

\* This field should not be set ever. Setting fnext.last field will generate a decode descriptor error

Table 296. 0x0C - poll - Polling address

31			1	0
addr			trig_val	
31 : 1	addr	MSB of 2 byte aligned address to be polled during descriptor execution if the current descriptor is a polling descriptor.		
0	trig_val	Expected input trigger value if the current descriptor is a triggering descriptor 0- Positive edge/high level based on the 'ctrl.trtp' field value of the descriptor. 1 - Negative edge/low level based on the 'ctrl.trtp' field value of the descriptor.		

Table 297. 0x10 - sts - Descriptor status word

31			3	2	1	0
Reserved			cpass	err	done	
31 : 3	-	Reserved				
2	cpass	Status of condition check. 1 - Conditional descriptor executed successfully. 0 - Conditional descriptor execution failed.				
1	err	Descriptor execution error status. 0 - No error. 1 - Error during execution				
0	done	Descriptor completion without error. 0 - Not completed 1 - Completed				

Table 298. 0x14 - expd - Expected data

31			0
data			
31 : 0	data	Expected data for polling type of descriptor execution. GRDMAC2 compares polling result with this data during descriptor execution.	

Table 299. 0x18 - cond - Conditional Mask

31	0
mask	
31 : 0	mask
	Mask for polling type of descriptor execution. GRDMAC2 compares polling result with this mask during descriptor execution. Polling result data bits corresponding to mask bits which are set to one, is only considered for condition check comparison with expected data ('expd.data').

## 29.4 Interrupts

GRDMAC2 provides fine-grained control of interrupt generation. At the highest level, the global Interrupt Enable bit ('IE') in GRDMAC2 control register(CTRL) can be set to zero to mask every interrupt setting in GRDMAC2. If set to one, interrupt generation depends on the following settings. The Interrupt on Error Enable bit ('IER') in CTRL register provides a way to generate interrupts in the event of errors. Error generation is discussed further in section 29.5. An interrupt can be also generated by the successful completion of a descriptor, if the Interrupt Enable ('irqe') bit is set to one in the descriptor's control field. The Interrupt Mask bit ('IM') in the CTRL register can be set to one to mask the descriptor completion interrupts. Descriptor completion interrupt will be generated as soon as the successful completion of the descriptor execution. Even before writing back the descriptor's status in main memory, if the write back is enabled. For both interrupts on error and interrupts on descriptor completion events, a flag will be raised in the interrupt flag bit('IF') in GRDMAC2 status register. Interrupt generated on descriptor completion can be masked by configuring 'IM' bit even though 'IE' bit in CTRL register and 'irqe' bit in descriptor control word is set to one. However it is not possible to mask the interrupt generated on error when 'IE' bit in CTRL register is set to one. As an example of interrupt generation setup, one can perform the following steps. The Interrupt Enable ('IE') bit in CTRL register must be set to one. The Interrupt Mask ('IM') bit in CTRL register must be configured as zero. Set up a descriptor queue with a single data descriptor. Configure Interrupt Enable ('irqe') bit in the control field of the descriptor as one and mark the descriptor as the last descriptor. When the descriptor queue is completed successfully, an interrupt will be generated.

## 29.5 Status and Errors

GRDMAC2 provides a very clear status display by an APB status register and 8 separate debug capability registers which displays details of the current descriptor that is being executed.

There is a general error flag 'ERR' which will be set in any case of error and an individual flag which says the type of error that has occurred. A decode descriptor error('DE') can occur during the decoding of a descriptor if the type of descriptor is not a valid value(0 to 3 is only valid) for current version of GRDMAC2. Another situation which can generate this error is when a conditional descriptor has it's 'fnext.last' bit set to one. A read descriptor error('RE') will be flagged in GRDMAC2 status register in case when the Bus Master Interface receives an error response during the descriptor read burst memory access. A polling error flag('PE') can be set in two cases. One case is when a Bus Master Interface receives an error response during the read access on the address being polled.

Another case is when timeout occurs during a polling descriptor execution and the descriptor is configured to treat timeout as an error. A triggering error('TRE') will be generated when a triggering type descriptor encounters a timeout and the descriptor is configured to treat timeout as an error. When the Bus Master Interface receives an error response during the write access on descriptor status word in the memory, a write back error('WBE') is flagged in GRDMAC2 status register. If the Bus Master Interface receives an error response during any part of the read accesses performed as part of M2B operation, M2B read data error flag('RDE') will be set status register. Similarly, in case the Bus Mas-

# LEON3FT Microcontroller

ter Interface receives an error response during any part of the write accesses performed as part of B2M operation, B2M write data error

flag(‘*WDE*’) will be set in status register. A FIFO error(‘*FE*’) is flagged in GRDMAC2 status register only when an uncorrectable error status is reported from the internal FIFO. In such a situation the ‘*FP*’ field will be pointing to the offset in FIFO where the error has been detected. When GRDMAC2 receives a kick request, it reads the next descriptor pointer of the current descriptor again. If the Bus Master Interface receives an error response while this read access, a ‘*NPE*’ flag will be set in APB status register. Timeout status flag ‘*TO*’ will be set in case of a timeout during the conditional descriptor execution. All error flags are cleared on writing 1 to them. However the timeout flag ‘*TO*’ is self clearing. In case of an error, GRDMAC2 pauses the execution and stays idle. Along with appropriate error flags, ‘*PAU*’ flag will be set in GRDMAC2 status register. GRDMAC2 allows the user to clear the errors and kick GRDMAC2 to continue execution from the next descriptor in the queue.

GEDMAC2 has a 5 bit ‘*ST*’ field which always displays the current state of descriptor execution. In case of any error, the ‘*ST*’ field will freeze at the execution state where the error occurred. When GRDMAC2 is performing descriptor execution in a descriptor queue, the ‘*ONG*’ bit in GRDMAC2 status register will be set to one. In case of an error or if GRDMAC2 has completed the execution of the entire queue, GRDMAC2 stays idle and clears the ‘*ONG*’ bit, indicating that no operation is currently in progress. ‘*CMP*’ flag is set to one, only when the descriptor queue is executed completely.

There are two self clearing flags ‘*KP*’ and ‘*RSP*’ which shows the existence of a pending kick request and a pending restart request. ‘*KP*’ flag will be cleared whenever a new descriptor is taken up for execution. In other words, GRDMAC2 handles kick by reading the ‘*next*’ field of the current descriptor again from the memory and processing it. ‘*RSP*’ bit is cleared when the current descriptor execution is completed and DMA operation restarted from the first descriptor. The debug capability registers displays all the fields of the current descriptor that is being executed.

The descriptor pointer debug capability register shows the base address where the current descriptor was read from.

## 29.6 GRDMAC2 Use case Example

A simple example showing how GRDMAC2 can be used with APBUART is explained below. In this example GRDMAC2 is used to read data, whenever a peripheral APBUART receives data from a host. GRDMAC2 transfers data from the APBUART receiver register to main memory. Assume that the system has SRAM memory at 0x30000000 and UART configuration registers are located at 0x80300000.

Set up a descriptor queue with 3 descriptors. A polling descriptor followed by a data descriptor and a disabled data descriptor. Descriptor queue should be written to a memory location (assuming 0x30000000). The descriptor configuration is listed below.

a) Polling descriptor:

# LEON3FT Microcontroller

Table 300. GRDMAC2 use case example- Conditional descriptor configuration

Field	Value	Comment
ctrl.en	1	Enabled descriptor
ctrl.type	1	Polling descriptor
ctrl.wb	1	Execution status write back is enabled
ctrl.irqn	-	Irrelevant for polling descriptors
ctrl.trtp	-	Irrelevant for polling descriptors
ctrl.intrv	0xFF	0xFF clock cycles between two polling accesses
ctrl.count	0xFF	Repeat polling condition check for 0xFF iterations before assuming failed execution status
ctrl.bm	1	Bus Master Interface 1 is to be used for UART status register polling
ctrl.errto	0	Timeout is not an error
ctrl.irqe	1	Interrupt enabled on descriptor completion
next.addr	0x3000001C	Pointer to next descriptor
nxt_des.last	0	Not last descriptor
f_nxt_des.addr	0x30000030	Pointer to next descriptor if the current descriptor execution failed.
f_nxt_des.last	0	Mandatory value
poll.trg_val	-	Irrelevant for polling descriptors
poll.addr	0x80300004	APBUART status register address.
expd.data	0x00000001	Expects data ready to be 1. Break, Framing error, Parity error and Overrun bits to be 0.
cond.mask	0x00000079	Consider bit 0, 3, 4, 5 and 6 for comparison using the condition check in table 285

## b) Data descriptor 1

This descriptor is written at 0x3000001C

Table 301. GRDMAC2 use case example- Data descriptor configuration

Field	Value	Comment
ctrl.en	1	Enabled descriptor
ctrl.type	0	Data descriptor
ctrl.wb	1	Execution status write back is enabled
ctrl.dstbm	0	Bus master interface 0 is to be used for data write to SRAM area.
ctrl.srcbm	1	Bus master interface 1 is to be used for data fetch from UART RX register.
ctrl.destfix	0	Write data to incrementing destination address offsets
ctrl.srcfix	1	Fetch data always from the same source address
ctrl.irqe	1	Interrupt enabled on descriptor completion
ctrl.size	64	Transfer 64 bytes of data
next.addr	0x30000000	Pointer to next descriptor. This essentially creates a loop of polling- data transfer process
nxt_des.last	0	Not last descriptor
dest.addr	0x30000080	SRAM area where data read from UART is to be written
src.addr	0x80300000	APBUART data register from where data is to be read.

5. Write the same data descriptor described in step **b** at address 0x30000030 with '*ctrl.en*' bit as zero and '*nxt\_des.last*' bit as 1. This disabled data descriptor is pointed as the descriptor to be executed on failure for the first polling descriptor.
6. Configure GRDMAC2 '*FPTR*' register as 0x30000000, control register bit field '*TE*' as zero.
7. After configuring descriptor queue and GRDMAC2 registers, start GRDMAC2 operation by setting GRDMAC2 control register(CTRL) '*EN*' bit field as one.

GRDMAC2 should transfer data from UART data register whenever the data ready bit in APBUART status register is set. Transferred data can be read from the destination SRAM area and verified.

# LEON3FT Microcontroller

## 29.7 Registers

GRDMAC2 is programmed through registers mapped into APB address space.

Table 302. GRDMAC2 APB registers

APB address offset	Register
0x00	Control register
0x04	Status register
0x08	Timer reset value register
0x0C	Capability register
0x10	First descriptor pointer
0x14	Descriptor control word for debug capability
0x18	Next Descriptor pointer for debug capability
0x1C	fnext/dest.addr for debug capability*
0x20	poll.addr/src.addr for debug capability*
0x24	Descriptor status for debug capability
0x28	expd.data/Null for debug capability*
0x2C	cond.mask /Null for debug capability*
0x30	Current descriptor pointer for debug capability

\*Debug capability register field according to the current descriptor type is conditional/data

# LEON3FT Microcontroller

## 29.7.1 Control register

Table 303. 0x00 - CTRL - Control register

31	8	7	6	5	4	3	2	1	0
Reserved		TE	IER	IM	IE	RT	KICK	RST	EN
0		0	0	0	0	0	0	0	0
r		rw	rw	rw	rw	rw	rw	rw	rw

31 : 8	-	Reserved
7	TE	Timeout check enable during conditional descriptor execution.
6	IER	Enable interrupt generation on error events
5	IM	Mask interrupt generation on descriptor completion.
4	IE	Enable interrupt generation. 0 - Disable interrupt all type of generation 1- Enable interrupt generation
3	RT	Restart current descriptor queue execution.
2	KICK	Kick GRDMAC2. GRDMAC2 reads the next descriptor pointer word of the current descriptor again when there is a kick request.
1	RST	Reset GRDMAC2. Setting this bit to one resets the core completely.
0	EN	Enable DMA controller.

## 29.7.2 Status register

Table 304. 0x04 - STS - Status Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
NPE	WDE	RDE	TO	WBE	TRE	PE	RE	DE	KP	RSP	IF	PAU	ONG	ERR	CMP
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
wc	wc	wc	wc	wc	wc	wc	wc	wc	r	r	wc	r	r	wc	r



# LEON3FT Microcontroller

31		27	26	17	16
ST		FP		FE	
0		0		0	
r		r		wc	
31 : 27	ST	Current GRDMAC2 operation state			
26 : 17	FP	FIFO offset at which error encountered.			
16	FE	FIFO error. Error reported from GRDMAC2 internal FIFO.			
15	NPE	Error during reading next descriptor pointer register, on a kick request			
14	WDE	Error while writing data during B2M operation.			
13	RDE	Error while reading data during M2B operation.			
12	TO	Timeout during conditional descriptor execution.			
11	WBE	Write back error.			
10	TRE	Triggering descriptor error.			
9	PE	Polling error.			
8	RE	Read descriptor error.			
7	DE	Decode descriptor error.			
6	KP	Pending kick request.			
5	RSP	Pending restart request.			
4	IF	Interrupt flag.			
3	PAU	Paused descriptor queue execution.			
2	ONG	Ongoing descriptor queue execution.			
1	ERR	Error during descriptor queue execution.			
0	CMP	Completed execution of the descriptor queue.			

# LEON3FT Microcontroller

## 29.7.3 Timer reset value register

Table 305. 0x08 - TRST - Timer reset value register

31	0
VAL	
0	
rw	

31 : 0 VAL Reset value of the timeout counter for timeout check mechanism.

## 29.7.4 Capability Register

Table 306. 0x0C - CAP - Capability Register

31	28	27	12	11	9	8	7	5	4	3	0
BFDP		Reserved			DW		TE	FT	BM1	VER	
4		0			2		1	1	1	0	
r		r			r		r	r	r	r	

31 : 28 BFDPA Address bits of internal FIFO.  
 27 : 12 - Reserved  
 11 : 9 DW Bus master interface front end data width is set to 32 bits.  
 8 TE Timeout mechanism support.  
 7 : 5 FT Fault tolerant support  
 4 BM1 Second Bus Master Interface support.  
 3 : 0 VER Revision of GRDMAC2

## 29.7.5 First descriptor pointer

Table 307. 0x10 - FPTR - First descriptor pointer

31	0
addr	
0	
rw	

31 : 0 addr First descriptor pointer register. Points to first descriptor of the descriptor queue.

## 29.7.6 Descriptor control word for debug capability

Table 308. 0x14 - DCTR - Descriptor control word for debug capability

31	0
ctrl	
0	
r	

31 : 0 ctrl Current descriptor's control field for debug capability.

# LEON3FT Microcontroller

## 29.7.7 Next Descriptor pointer for debug capability

Table 309.0x18 - DNXT - Next Descriptor pointer for debug capability

31	0
addr	
0	
r	

31 : 0      addr      Current descriptor's next descriptor field for debug capability

## 29.7.8 fnext/dest.addr for debug capability

Table 310.0x1C - DFNX - fnext/dest.addr for debug capability

31	0
addr	
0	
r	

31 : 0      addr      Current descriptor's next descriptor field on failure for debug capability/  
Current descriptor's destination address field for debug capability\*

\* Debug capability field depends on the descriptor type.

## 29.7.9 poll.addr/src.addr for debug capability

Table 311. 0x20 - DPOL- poll.addr/src.addr for debug capability

31	0
addr	
0	
r	

31 : 0      addr      Current descriptor's 'poll.addr' for debug capability/Current  
descriptor's src.addr field for debug capability\*

\* Debug capability field depends on the descriptor type.

## 29.7.10 Descriptor status for debug capability

Table 312. 0x24 - DSTS - Descriptor status for debug capability

31	0
sts	
0	
r	

31 : 0      sts      Current descriptor's status word for debug capability

# LEON3FT Microcontroller

## 29.7.11 Expected data for debug capability

Table 313. 0x28 - DDTA- Expected data for debug capability

31	0
data	
0	
r	

31 : 0 data Current descriptor's expected data(expd.data) for debug capability\*

\* This field value is null for a data descriptor.

## 29.7.12 Conditional mask for debug capability

Table 314. 0x2C - DMSK - Conditional mask for debug capability

31	0
mask	
0	
r	

31 : 0 mask Current descriptor's conditional mask for debug capability\*

\* This field value is null for a data descriptor.

## 29.7.13 Current descriptor pointer for debug capability

Table 315. 0x30 - DPTR - Current descriptor pointer for debug capability

31	0
addr	
0	
r	

31 : 0 addr Pointer from which the current descriptor is read, for debug capability

# LEON3FT Microcontroller

## 30 General Purpose I/O Port

The GR716 microcontroller has 2 separate General Purpose I/O port (GRGPIO) units. Each General Purpose I/O port (GRGPIO) units controls its own external pins and has a unique AMBA address described in chapter 2.10.

The General Purpose I/O port (GRGPIO) units are located on APB bus in the address range from 0x8030C000 to 0x8030CFFF and 0x8030D000 to 0x8030DFFF. See General Purpose I/O port (GRGPIO) units connections in the next drawing. The figure shows memory locations and functions used for General Purpose I/O port (GRGPIO) configuration and control.

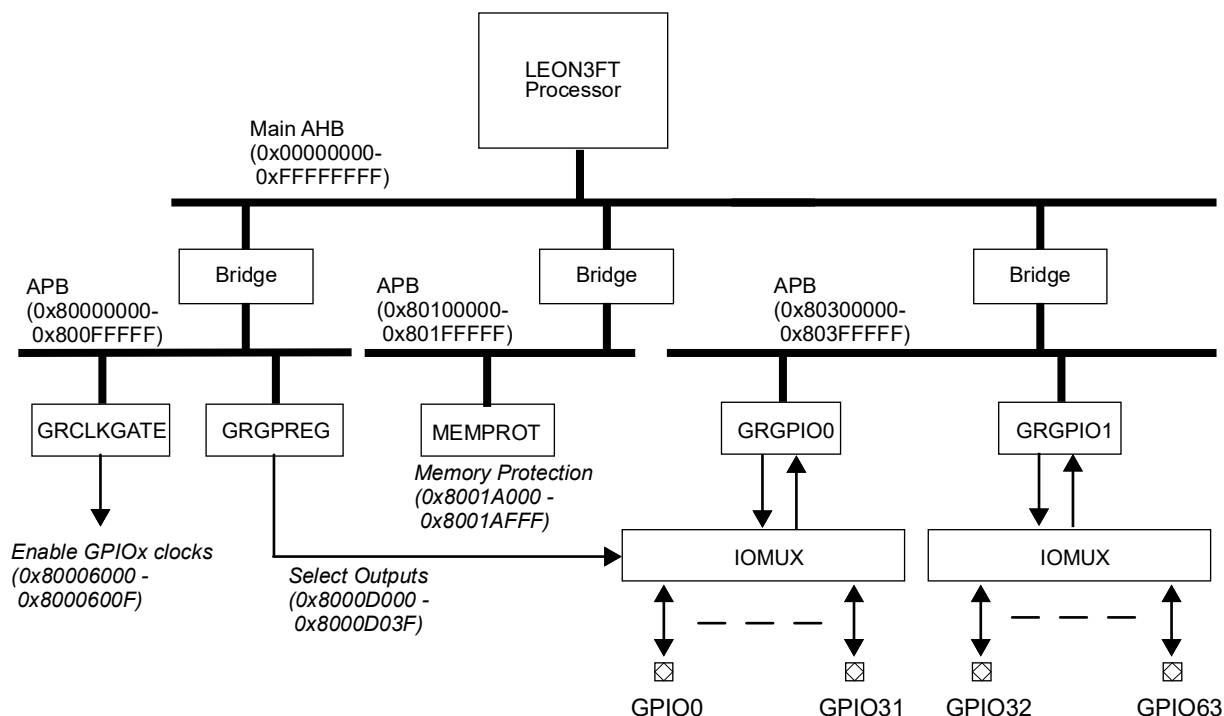


Figure 55. GR716 GRGPIO bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable individual General Purpose I/O port (GRGPIO) units. The unit **GRCLKGATE** can also be used to perform reset of individual General Purpose I/O port (GRGPIO) units. Software must enable clock and release reset described in section 27 before General Purpose I/O port (GRGPIO) configuration and transmission can start.

External IO selection per General Purpose I/O port (GRGPIO) unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

Each **GRGPIOx** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. GRGPIO unit 0 and 1 have identical configuration and status registers. Configuration and status registers are described in section 30.4.

The system can be configured to protect and restrict access to individual General Purpose I/O port (GRGPIO) unit in the **MEMPROT** unit. See section 47 for more information.

# LEON3FT Microcontroller

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## 30.1 Overview

All 64 external pins can be configured as general purpose I/O. Each external pin in the general purpose mode can be individually set to input or output, and can optionally generate an interrupt. For interrupt generation, the input can be filtered for polarity and level/edge detection.

The GR716 microcontroller comprises two This chapter describes one GPIO unit. The two GPIO units in the GR716 are identical except for the physical external pin connected to GPIO unit 1 and GPIO unit 2. For separation in this document GPIO unit 1 are connected to external pins 0 to 31 . GPIO unit 2 are connected to external pins 32 to 64. Each GPIO unit have a unique AMBA address described in chapter 2.10.

## 30.2 Operation

All external I/Os have bi-directional buffers with programmable output enable. The input from each buffer is synchronized by two flip-flops in series to remove potential meta-stability. The synchronized values can be read-out from the I/O port data register. The output enable is controlled by the I/O port direction register. A '1' in a bit position will enable the output buffer for the corresponding I/O line. The output value driven is taken from the I/O port output register.

The GPIO interrupts has been implemented to support dynamic mapping of interrupts, each I/O line can be mapped using the Interrupt map register(s) to an interrupt line.

Interrupt generation is controlled by three registers: interrupt mask, polarity and edge registers. To enable an interrupt, the corresponding bit in the interrupt mask register must be set. If the edge register is '0', the interrupt is treated as level sensitive. If the polarity register is '0', the interrupt is active low. If the polarity register is '1', the interrupt is active high. If the edge register is '1', the interrupt is edge-triggered. The polarity register then selects between rising edge ('1') or falling edge ('0').

The GPIO core includes an Interrupt flag register that can be used to determine if, and which, GPIO pin that caused an interrupt to be asserted.

## 30.3 Pulse command (TBD)

The pulse command outputs use one of the GR716 microcontroller common counter for establishing the pulse command start and length. The pulse command length defines the logical active part of the pulse. It is possible to select which of the channels shall generate a pulse command. The pulse command outputs are generated in phase with a selected trigger source. To send synchronized pulse commands on multiple outputs simultaneously the same trigger source shall be enabled for the selected outputs.

## 30.4 Registers

The core is programmed through registers mapped into APB address space.

Table 316. General Purpose I/O Port registers

APB address offset	Register
0x00	I/O port data register
0x04	I/O port output register
0x08	I/O port direction register
0x0C	Interrupt mask register
0x10	Interrupt polarity register
0x14	Interrupt edge register
0x1C	Capability register
0x20 - 0x3C	Interrupt map register(s).
0x40	Interrupt available register
0x44	Interrupt flag register
0x48	Input enable register
0x4C	Pulse register
0x50	Input enable register, logical-OR
0x54	I/O port output register, logical-OR
0x58	I/O port direction register, logical-OR
0x5C	Interrupt mask register, logical-OR
0x60	Input enable register, logical-AND
0x64	I/O port output register, logical-AND
0x68	I/O port direction register, logical-AND
0x6C	Interrupt mask register, logical-AND
0x70	Input enable register, logical-XOR
0x74	I/O port output register, logical-XOR
0x78	I/O port direction register, logical-XOR
0x7C	Interrupt mask register, logical-XOR

# LEON3FT Microcontroller

## 30.4.1 I/O Port Data Register

Table 317.0x00 - DATA - I/O port data register

31		0
	DATA	
	*	
	r	

31: 0 I/O port input value (DATA) - Data value read from GPIO lines

## 30.4.2 I/O Port Output Register

Table 318.0x04 - OUTPUT - I/O port output register

31		0
	DATA	
	0	
	rw	

31: 0 I/O port output value (DATA) - Output value for GPIO lines

## 30.4.3 I/O Port Direction Register

Table 319.0x08 - DIRECTION - I/O port direction register

31		0
	DIR	
	0	
	rw	

31: 0 I/O port direction value (DIR) - 0=output disabled, 1=output enabled

## 30.4.4 Interrupt Mask Register

Table 320.0x0C - IMASK - Interrupt mask register

31		0
	MASK	
	0	
	rw	

31: 0 Interrupt mask (MASK) - 0=interrupt masked, 1=interrupt enabled

## 30.4.5 Interrupt Polarity Register

Table 321.0x10 - IPOL - Interrupt polarity register

31		0
	POL	
	NR	
	rw	

31: 0 Interrupt polarity (POL) - 0=low/falling, 1=high/rising



# LEON3FT Microcontroller

## 30.4.6 Interrupt Edge Register

Table 322.0x14 - IEDGE - Interrupt edge register

31	0
EDGE	
NR	
rw	

31: 0 Interrupt edge (EDGE) - 0=level, 1=edge

## 30.4.7 Capability Register

Table 323.0x1C - CAP - Capability register

31		18	17	16	15		13	12		8	7		5	4	0
RESERVED				PU	IER	IFL	r	IRQGEN			r	NLINES			
0				1	1	1	0	0x4			0	0x1F			
r				r	r	r	r	r			r	r			

- 31: 19 Reserved and not used
- 18 PU: Pulse register implemented: If this field is '1' then the core implements the Pulse register.
- 17 IER: Input Enable register implemented. If this field is '1' then the core implements the Input enable register.
- 16 IFL: Interrupt flag register implemented. If this field is '1' then the core implements the Interrupt available and Interrupt flag registers (registers at offsets 0x40 and 0x44).
- 12 8 IRQGEN: Software can dynamically configure each I/O to drive either of the 4 interrupt lines associated with each GPIO unit (cf. section 2.12).
- 4: 0 NLINES. Number of pins in GPIO port - 1.

## 30.4.8 Interrupt Map Register n

Table 324.0x20 - 0x3C - IRQMAPRn - Interrupt map register n

31	29	28		24	23	21	20		16	15	13	12		8	7		6	4	0
RESERVED		IRQMAP[4*n]		RESERVED		IRQMAP[4*n+1]		RESERVED		IRQMAP[4*n+2]		RESERVED		IRQMAP[4*n+3]					
0		un+i		0		un+i+1		0		un+i+2		0		un+i+3					
r		rw		r		rw		r		rw		r		rw					

31: 0 IRQMAP[i] : The field IRQMAP[i] determines to which interrupt I/O line i is connected. If IRQMAP[i] is set to x, IO[i] will drive interrupt  $pirq+x$ . Where  $pirq$  is the first interrupt assigned to the core (cf. section 2.12). Several I/O can be mapped to the same interrupt.

The core has one IRQMAP field per I/O line. The Interrupt map register at offset  $0x20+4*n$  contains the IRQMAP fields for  $IO[4*n : 4*n+3]$ . This means that the fields for IO[0:3] are located on offset 0x20, IO[4:7] on offset 0x24, IO[8:11] on offset 0x28, and so on. An I/O line's interrupt generation must be enabled in the Interrupt mask register in order for the I/O line to drive the interrupt specified by the IRQMAP field.

## 30.4.9 Interrupt Available Register

Table 325.0x40 - IAVAIL - Interrupt available register

31	0
IMASK	
*	
r	

31: 0 IMASK: Interrupt mask bit field. If IMASK[n] is 1 then GPIO line n can generate interrupts.

# LEON3FT Microcontroller

## 30.4.10 Interrupt Flag Register

Table 326.0x44 - IFLAG - Interrupt flag register

31	0
IFLAG	
0	
wc	

31: 0 IFLAG : If IFLAG[n] is set to '1' then GPIO line n has generated an interrupt. Write '1' to the corresponding bit to clear. Writes of '0' have no effect.

## 30.4.11 Input Enable Register

Table 327.0x48 - IPEN - Input enable register

31	0
IPEN	
0	
rw	

31: 0 IPEN : If IPEN[n] is set to '1' then values from GPIO line n will be visible in the data register. Otherwise the GPIO line input is gated-off to disable input signal propagation.

## 30.4.12 Pulse Register

Table 328.0x4C - PULSE - Pulse register

31	0
PULSE	
0	
rw	

31: 0 PULSE : If PULSE[n] is set to '1' then I/O port output register bit n will be inverted whenever selected synchronization source is active. Synchronization source is selected in register SEQSYNC.

## 30.4.13 Logical-OR/AND/XOR Register

Table 329.0x54-0x7C - LOR, LAND, LXOR - Logical-OR/AND/XOR registers

31	0
VALUE	
-	
w*	

31: 0 The logical-OR/AND/XOR registers will update the corresponding register according to:  
 New value = <Old value> logical-op <Write data>  
 There exists logical-OR, AND and XOR registers for the Input enable, I/O port output, I/O port direction and Interrupt mask registers.

## 30.4.14 Logical-Set&Clear Register

Table 330.0x80-0xB8 - Logical Set&Clear - Logical-OR/AND/XOR registers

31	0
VALUE	
-	
w*	

# LEON3FT Microcontroller

---

Table 330.0x80-0xB8 - Logical Set&Clear - Logical-OR/AND/XOR registers

---

- 31: 0 The logical-Set&Clear registers will update the corresponding register according to:  
New value = (<Old value> OR <First write>) OR (<Old value> AND NOT <Second write>)  
The first write is used to 'set' bits and second write is used to 'clear' bits.

# LEON3FT Microcontroller

## 31 PacketWire Receiver

### 31.1 Overview

The PacketWire Receiver implements a receiver function with Direct Memory Access (DMA) support. Packets (or blocks of data, normally CCSDS Space Packets) are automatically stored to memory, for which the user configures a descriptor table with descriptors that point to each individual packet or one or more packets stored in a fixed length fields (framing mode).

The core provides the following external and internal interfaces:

- Packet Wire interface (serial bit data, bit clock, packet delimiter, abort, ready, busy)
- AMBA AHB master interface, with sideband signals as per [GRLIB]
- AMBA APB slave interface, with sideband signals as per [GRLIB]

The operation of the receiver is highly programmable by means of control registers.

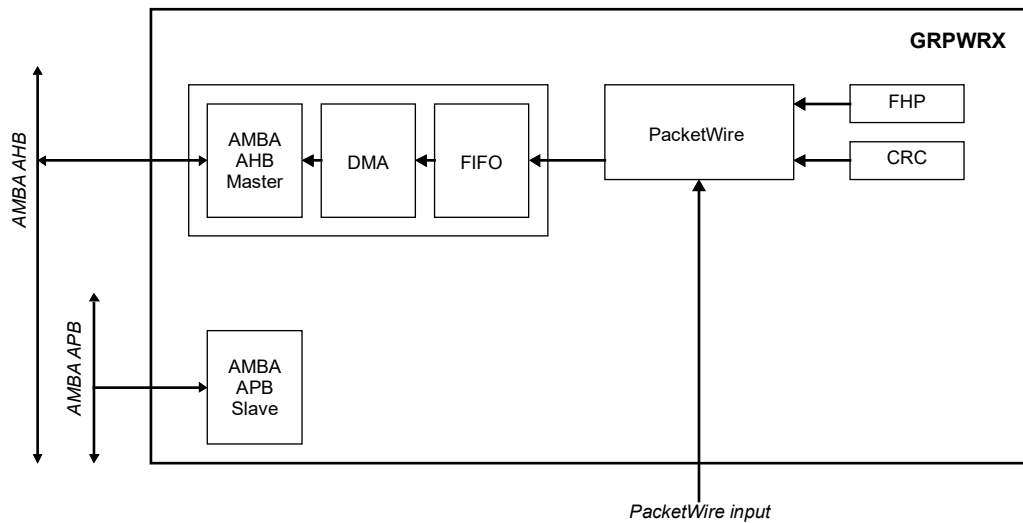


Figure 56. Block diagram

### 31.2 PacketWire interface

A PacketWire link comprises four ports for transmitting the message delimiter, the bit clock, the serial bit data and an abort signal. A link also comprises additional ports for busy signaling, indicating when the receiver is ready to receive the next octet, and for ready signaling, indicating that the receiver is ready to receive a complete packet. The waveform format shown in figure 57.

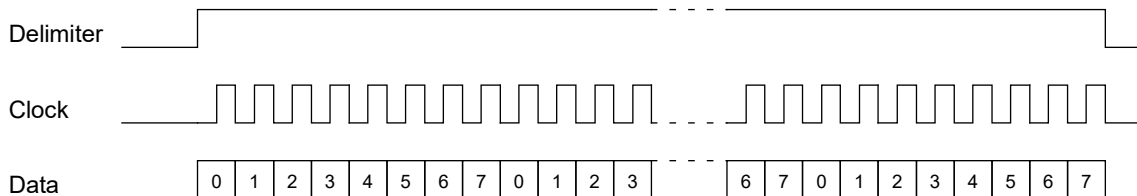


Figure 57. Synchronous bit serial waveform

The PacketWire protocol follows the CCSDS transmission convention, the most significant bit being sent first, both for octet transfers (control), and for word transfer (address or data). Transmitted data should consist of multiples of eight bits otherwise the last bits will be lost. The message delimiter port

# LEON3FT Microcontroller

is used to delimit messages (commands). It should be asserted while a message is being input, and deasserted in between. In addition, the message delimiter should define the octet boundaries in the data stream, the first octet explicitly and the following octets each subsequent eight bit clock cycles. The delimiter should be de-asserted for at least eight bit periods between messages.

The handshaking between the PacketWire link and the interface is implemented with a busy port. When a message is sent, the busy signal on the PacketWire link will be asserted as soon as the first data bit is detected, it will then be deasserted as soon as the interface is ready to receive the next octet. This gives the transmitter ample time to stop transmitting after the completion of the first octet and wait for the busy signal deassertion before starting the transmission of the next octet. The handshaking is continued through out the message. At the end of message, the busy signal will be asserted until the completion of the message.

## 31.3 Operation

## 31.4 Operation

### 31.4.1 Introduction

The DMA interface provides a means for the user to receive blocks of data of arbitrary length (maximum 65535 bytes), normally these are packet structures such as CCSDS Space Packets. It also supports reception of one or more blocks of data into a fixed length field such as a CCSDS Telemetry Transfer Frame Data Field (framing mode).

### 31.4.2 Descriptor setup

The DMA interface is used for receiving data. The reception is done using descriptors located in memory. A single descriptor is shown in tables 331 through 332. The address field of the descriptor should point to the start of where the received data is to be stored. The address need not be word-aligned. If the interrupt enable (IE) bit is set, an interrupt will be generated when the transfer has completed (this requires that the interrupt enable bit in the control register is also set). The interrupt will be generated regardless of whether the transfer was successful or not. The wrap (WR) bit is also a control bit that should be set before reception and it will be explained later in this section..

Table 331. GRPWRX descriptor word 0 (address offset 0x0)

31	16	15	9	8	7	6	4	3	2	1	0
LEN	RESERVED		CERR	OV	RESERVED		FHP	WR	IE	EN	

- 31: 16 (LEN) - Length in bytes (note that length is limited to 2048 bytes for framing mode)  
In packet mode, the LEN field is written by the hardware after the reception.  
In framing mode, the LEN field is written by the software before reception.
- 15: 9 RESERVED
- 8: Cyclic Redundancy Code Error (CERR) - (read only) Set to one when a CRC error was detected in a packet (speculative, only useful if CRC is present in received packet)
- 7: Overrun (OV) - (read only) Overrun detected during transmission.
- 6: 3 RESERVED
- 3: First Header Pointer (FHP) - First Header Pointer to be stored (2 bytes)
- 2: Wrap (WR) - Set to one to make the descriptor pointer wrap to zero after this descriptor has been used. If this bit is not set the pointer will increment by 16. The pointer automatically wraps to zero when the 16 kB boundary of the descriptor table is reached.
- 1: Interrupt Enable (IE) - an interrupt will be generated when data for this descriptor has been received provided that the receive interrupt enable bit in the control register is set. The interrupt is generated regardless if the data was transferred successfully or if it terminated with an error.
- 0: Enable (EN) - Set to one to enable the descriptor. Should always be set last of all the descriptor fields.

# LEON3FT Microcontroller

Table 332. GRPWRX descriptor word 1 (address offset 0x4)

31	0
ADDRESS	

31: 0      Address (ADDRESS) - Pointer to the buffer area to where data will be stored.

To enable a descriptor the enable (EN) bit should be set and after this is done, the descriptor should not be touched until the enable bit has been cleared by the core.

### 31.4.3 Packet mode

In packet mode, each descriptor corresponds to one received packet. The maximum length of a packet can be 65535 bytes. There is no check for too long packets. Reception of any too long packet will result in indeterministic behavior. The length of the received packet is automatically written into descriptor word 0.

### 31.4.4 Framing mode

In framing mode, each pair of descriptors correspond to one fixed length field as the CCSDS Telemetry Transfer Frame Data Field. The first descriptor defines the length (fixed for a field) and position in memory where the data is to be stored. The second descriptor in a pair defines the fixed length (2 bytes) and position of the memory where the First Header Pointer (FHP) calculated for the data received in a field belonging to the previous descriptor is to be stored. The First Header Pointer is calculated according to CCSDS: if the first packet starts at the beginning of the field then it is all zeros, if no packet starts in the field then it is all ones, any other location of the start of the first packet in a field is its count from the start of the field minus one. The First Header Pointer write-back is enabled by setting the FHP bit in the descriptor word 0. Normally the start location of First Header Pointer is two bytes in front of the field when CCSDS Telemetry Transfer Frames are used.

### 31.4.5 Starting transmission

Enabling a descriptor is not enough to start transmission. A pointer to the memory area holding the descriptors must first be set in the core. This is done in the descriptor pointer register. The address must be aligned to a 16 kByte boundary. Bits 31 to 14 hold the base address of descriptor area while bits 13 to 4 form a pointer to an individual descriptor. The first descriptor should be located at the base address and when it has been used by the core, the pointer field is incremented by 16 to point at the next descriptor. The pointer will automatically wrap back to zero when the next 16 kByte boundary has been reached. The WR bit in the descriptors can be set to make the pointer wrap back to zero before the 16 kByte boundary.

The pointer field has also been made writable for maximum flexibility but care should be taken when writing to the descriptor pointer register. It should never be touched when reception is active.

The final step to activate the reception is to set the enable bit in the DMA control register. This tells the core that there are more active descriptors in the descriptor table. This bit should always be set when new descriptors are enabled, even if transmission is already active. The descriptors must always be enabled before the transmission enable bit is set.

### 31.4.6 Descriptor handling after transmission

When the reception of a packet (or field in framing mode) has finished, status is written to the first word in the corresponding descriptor, while the second word is left untouched. The other bits in the first descriptor word are set to zero after reception. The enable bit should be used as the indicator when a descriptor can be used again, which is when it has been cleared by the core.

If the Cyclic Redundancy Code (CRC) bit is set, a CRC calculated over all but the two last octets, will be checked and the results stored in the descriptor. The CRC is defined in

There are multiple bits in the DMA status register that hold status information.

# LEON3FT Microcontroller

The Receiver Interrupt (RI) bit is set each time a DMA reception ended successfully. The Receiver Error (RE) bit is set each time an DMA reception ended with an error. For either event, an interrupt is generated for transfers for which the Interrupt Enable (IE) was set in the descriptor. The interrupt is maskable with the Interrupt Enable (IE) bit in the control register.

The Receiver AMBA error (RA) bit is set when an AMBA AHB error was encountered either when reading a descriptor or when writing data. Any active reception was aborted and the DMA channel was disabled. It is recommended that the receiver is reset after an AMBA AHB error. The interrupt is maskable with the Interrupt Enable (IE) bit in the control register.

## 31.5 Registers

The core is programmed through registers mapped into APB address space.

Table 333. GRPWRX registers

APB address offset	Register
0x00	GRPWRX DMA Control register
0x04	GRPWRX DMA Status register
0x08	GRPWRX DMA Descriptor Pointer register
0x80	GRPWRX Control register
0x84	GRPWRX Status register
0x88	GRPWRX Configuration register
0x8C	GRPWRX Physical Layer register

# LEON3FT Microcontroller

## 31.5.1 DMA Control Register

Table 334.0x00 - DCR - DMA control register

31	2	1	0
RESERVED	IE	EN	
0	0	0	
r	rw	rw	

- 31: 2      RESERVED
- 1:          Interrupt Enable (IE) - enable interrupts RA, RI, and RE
- 0:          Enable (EN) - enable DMA transfers

## 31.5.2 DMA Status Register

Table 335.0x04 - DSR - DMA status register

31	4	3	2	1	0
RESERVED	ACTIVE	RA	RI	RE	
0	NR	0	0	0	
r	r	wc	wc	wc	

- 31: 4      RESERVED
- 3:          Active (ACTIVE) - DMA access ongoing
- 2:          Receiver AMBA Error (RA) - DMA AMBA AHB error, cleared by writing a logical 1
- 1:          Receiver Interrupt (RI) - DMA interrupt, cleared by writing a logical 1
- 0:          Receiver Error (RE) - DMA receiver error, cleared by writing a logical 1

## 31.5.3 DMA Descriptor Pointer Register

Table 336. 0x08 - DDP - DMA descriptor pointer register

31	14	13	4	3	0
BASE	INDEX	RESERVED			
NR	NR	0			
rw	rw	r			

- 31: 14      Descriptor base (BASE) - most significant bits of the base address of descriptor table
- 13: 4      Descriptor index (INDEX) - index of active descriptor in descriptor table
- 3: 0        Reserved - fixed to "0000"

## 31.5.4 Control Register

Table 337. 0x80 - CTRL - control register

31	3	2	1	0
RESERVED	RST	RES	RxEN	
0	0	1	0	
r	r	r	r	

- 31: 3      RESERVED
- 2:          Reset (RST) - resets complete core
- 1:          RESERVED
- 0:          Receiver Enable (RxEN) - enables receiver (should be done after the complete configuration of the receiver)



# LEON3FT Microcontroller

## 31.5.5 Status Register

Table 338. 0x84 - STAT - Status register

31		3	2	1	0
	RESERVED	VALID	BUSY	READY	
	0	0	1	0	
	r	r	r	r	

- 31: 3 RESERVED
- 2: Packet valid delimiter (VALID) - External valid signal
- 1: Busy with octet (BUSY) - External busy signal
- 0: Ready for packet (READY) - External ready signal

## 31.5.6 Configuration Register

Table 339. 0x88 - CONF - configuration register

31	24	23	8	7	1	0
	REVISION		FIFOSIZE		RESERVED	MODE
	*		*		0	0
	r		r		r	rw

- 31: 24 (REVISION) - Revision number (read-only)
- 23: 8 (FIFOSIZE) - FIFO size in bytes (read-only)
- 23: 1 RESERVED
- 0: (MODE) - Enable framing mode when set, else packet mode when cleared

## 31.5.7 Physical Layer Register

Table 340. 0x8C - PLR - physical layer register

31	20	19	8	7	6	5	4	3	0
	HALFBAUD		RESERVED	BUSY POS	READY POS	VALID POS	CLK RISE		RESERVED
	0		0	0	1	1	1		0
	r		r	rw	rw	rw	rw		r

- 31: 20 (HALFBAUD) - Received clock rate division factor with respect to the system clock - 1. Corresponds to the high phase of the incoming PacketWire bit clock. (read only)
- 19: 8 RESERVED
- 7: (BUSYPOS) - Positive polarity of busy input signal
- 6: (READYPOS) - Positive polarity of ready input signal
- 5: (VALIDPOS) - Positive polarity of valid output signal
- 4: (CLKRISE) - Rising clock edge in the middle of the serial data bit
- 3: 0 RESERVED

# LEON3FT Microcontroller

## 32 PacketWire Transmitter

### 32.1 Overview

The PacketWire Transmitter implements a transmit function with Direct Memory Access (DMA) support. Packets (or blocks of data, normally CCSDS Space Packets) are automatically fetched from memory, for which the user configures a descriptor table with descriptors that point to each individual packet.

The core provides the following external and internal interfaces:

- Packet Wire interface (serial bit data, bit clock, packet delimiter, abort, ready, busy)
- AMBA AHB master interface, with sideband signals as per [GRLIB]
- AMBA APB slave interface, with sideband signals as per [GRLIB]

The operation of the transmitter is highly programmable by means of control registers.

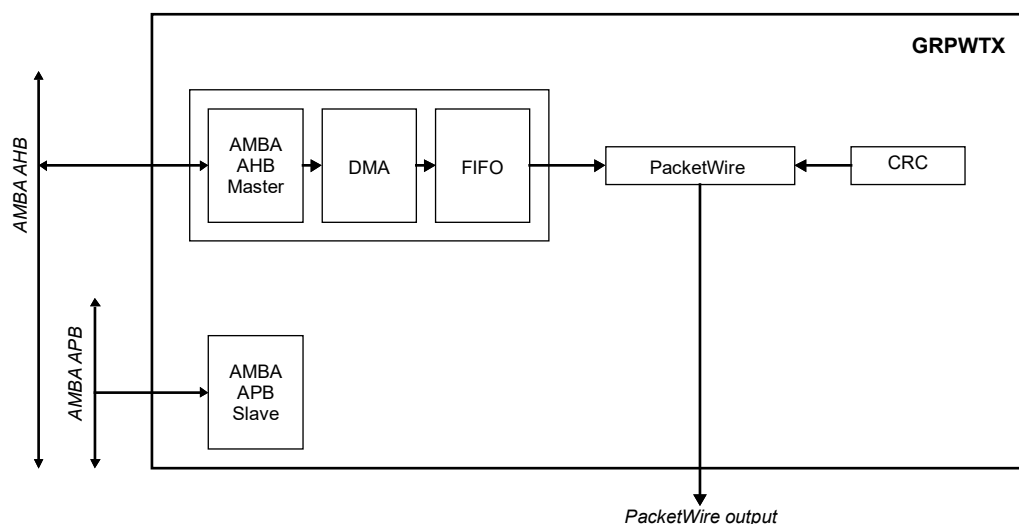


Figure 58. Block diagram

### 32.2 PacketWire interface

A PacketWire link comprises four ports for transmitting the message delimiter, the bit clock, the serial bit data and an abort signal. A link also comprises additional ports for busy signalling, indicating when the receiver is ready to receive the next octet, and for ready signalling, indicating that the receiver is ready to receive a complete packet. The waveform format shown in figure 59.

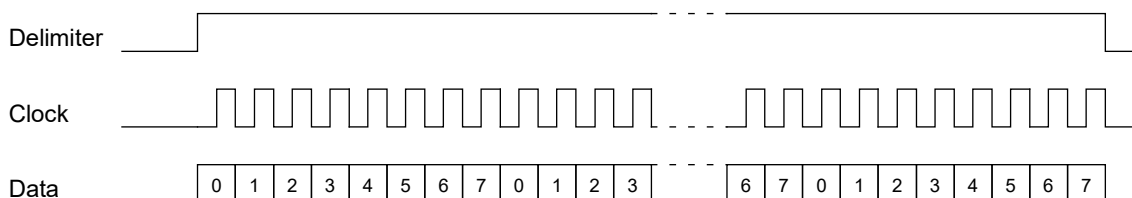


Figure 59. Synchronous bit serial waveform

The PacketWire protocol follows the CCSDS transmission convention, the most significant bit being sent first, both for octet transfers (control), and for word transfer (address or data). Transmitted data should consist of multiples of eight bits otherwise the last bits will be lost. The message delimiter port

# LEON3FT Microcontroller

is used to delimit messages (commands). It should be asserted while a message is being input, and deasserted in between. In addition, the message delimiter port should define the octet boundaries in the data stream, the first octet explicitly and the following octets each subsequent eight bit clock cycles.

The handshaking between the PacketWire link and the interface is implemented with a busy port. When a message is sent, the busy signal on the PacketWire link will be asserted as soon as the first data bit is detected, it will then be deasserted as soon as the interface is ready to receive the next octet. This gives the transmitter ample time to stop transmitting after the completion of the first octet and wait for the busy signal deassertion before starting the transmission of the next octet. The handshaking is continued through out the message. At the end of message, the busy signal will be asserted until the completion of the message.

## 32.3 Operation

### 32.3.1 Introduction

The DMA interface provides a means for the user to send blocks of data of arbitrary length, normally these are packet structures such as CCSDS Space Packets

### 32.3.2 Descriptor setup

The DMA interface is used for sending data on the uplink. The transmission is done using descriptors located in memory. A single descriptor is shown in tables 341 through 342. The address field of the descriptor should point to the start of the data to be sent. The address need not be word-aligned. If the interrupt enable (IE) bit is set, an interrupt will be generated when the transfer has completed (this requires that the interrupt enable bit in the control register is also set). The interrupt will be generated regardless of whether the transfer was successful or not. The wrap (WR) bit is also a control bit that should be set before transmission and it will be explained later in this section.

Table 341. GRPWTX descriptor word 0 (address offset 0x0)

31	16	15	8	7	6	4	3	2	1	0	
LEN		RESERVED			UR	RESERVED		CRC	WR	IE	EN

- 31: 16 (LEN) - length in bytes
- 15: 8 RESERVED
- 7: Underrun (UR) - Underrun detected during transmission.
- 6: 4 RESERVED
- 3: Cyclic Redundancy Code (CRC) - Insert CRC, overwriting the two last octets of a data block
- 2: Wrap (WR) - Set to one to make the descriptor pointer wrap to zero after this descriptor has been used. If this bit is not set the pointer will increment by 16. The pointer automatically wraps to zero when the 16 kB boundary of the descriptor table is reached.
- 1: Interrupt Enable (IE) - an interrupt will be generated when the data from this descriptor has been sent provided that the transmitter interrupt enable bit in the control register is set. The interrupt is generated regardless if the data was transferred successfully or if it terminated with an error.
- 0: Enable (EN) - Set to one to enable the descriptor. Should always be set last of all the descriptor fields.

Table 342. GRPWTX descriptor word 1 (address offset 0x4)

31	ADDRESS	0
----	---------	---

- 31: 0 Address (ADDRESS) - Pointer to the buffer area to where data will be fetched.

# LEON3FT Microcontroller

To enable a descriptor the enable (EN) bit should be set and after this is done, the descriptor should not be touched until the enable bit has been cleared by the core.

### 32.3.3 Starting transmission

Enabling a descriptor is not enough to start transmission. A pointer to the memory area holding the descriptors must first be set in the core. This is done in the descriptor pointer register. The address must be aligned to a 16 kByte boundary. Bits 31 to 14 hold the base address of descriptor area while bits 13 to 4 form a pointer to an individual descriptor. The first descriptor should be located at the base address and when it has been used by the core, the pointer field is incremented by 16 to point at the next descriptor. The pointer will automatically wrap back to zero when the next 16 kByte boundary has been reached. The WR bit in the descriptors can be set to make the pointer wrap back to zero before the 16 kByte boundary.

The pointer field has also been made writable for maximum flexibility but care should be taken when writing to the descriptor pointer register. It should never be touched when transmission is active.

If the Cyclic Redundancy Code (CRC) bit is set, a CRC calculated over all but the two last octets, will be inserted overwriting the two last octets of a data block. The CRC is defined in

The final step to activate the transmission is to set the enable bit in the DMA control register. This tells the core that there are more active descriptors in the descriptor table. This bit should always be set when new descriptors are enabled, even if transmission is already active. The descriptors must always be enabled before the transmission enable bit is set.

### 32.3.4 Descriptor handling after transmission

When the transmission has finished, status is written to the first word in the corresponding descriptor. The other bits in the first descriptor word are set to zero after transmission, while the second word is left untouched. The enable bit should be used as the indicator when a descriptor can be used again, which is when it has been cleared by the core.

There are multiple bits in the DMA status register that hold status information.

The Transmitter Interrupt (TI) bit is set each time a DMA transmission ended successfully. The Transmitter Error (TE) bit is set each time an DMA transmission ended with an error. For either event, an interrupt is generated for which the Interrupt Enable (IE) was set in the descriptor. The interrupt is maskable with the Interrupt Enable (IE) bit in the control register.

The Transmitter AMBA error (TA) bit is set when an AMBA AHB error was encountered either when reading a descriptor or data. Any active transmission was aborted and the DMA channel was disabled. It is recommended that the transmitter is reset after an AMBA AHB error. The interrupt is maskable with the Interrupt Enable (IE) bit in the control register.

## 32.4 Registers

The core is programmed through registers mapped into APB address space.

Table 343. GRPWTX registers

APB address offset	Register
0x00	GRPWTX DMA Control register
0x04	GRPWTX DMA Status register
0x08	GRPWTX DMA Descriptor Pointer register
0x80	GRPWTX Control register
0x84	GRPWTX Status register
0x88	GRPWTX Configuration register
0x8C	GRPWTX Physical Layer register

# LEON3FT Microcontroller

## 32.4.1 DMA Control Register

Table 344.0x00 - DCR - DMA control register

31	2	1	0
RESERVED	IE	EN	
0	0	0	
r	rw	rw	

- 31: 2      RESERVED
- 1:          Interrupt Enable (IE) - enable interrupts TA, TI, and TE
- 0:          Enable (EN) - enable DMA transfers

## 32.4.2 DMA Status Register

Table 345.0x04 - DSR - DMA status register

31	4	3	2	1	0
RESERVED	ACTIVE	TA	TI	TE	

- 31: 4      RESERVED
- 3:          Active (ACTIVE) - DMA access ongoing
- 2:          Transmitter AMBA Error (TA) - DMA AMBA AHB error, cleared by writing a logical 1
- 1:          Transmitter Interrupt (TI) - DMA interrupt, cleared by writing a logical 1
- 0:          Transmitter Error (TE) - DMA transmitter error, cleared by writing a logical 1

## 32.4.3 DMA Descriptor Pointer Register

Table 346. 0x08 - DDP - DMA descriptor pointer register

31	14	13	4	3	0
BASE	INDEX		RESERVED		
NR	NR		0		
rw	rw		r		

- 31: 14      Descriptor base (BASE) - most significant bits of the base address of descriptor table
- 13: 4      Descriptor index (INDEX) - index of active descriptor in descriptor table
- 3: 0        Reserved - fixed to "0000"

## 32.4.4 Control Register

Table 347. 0x80 - CTRL - control register

31	3	2	1	0
RESERVED	RST	R	TxEN	
0	0	0	0	
r	rw	r	rw	

- 31: 3      RESERVED
- 2:          Reset (RST) - resets complete core
- 1:          RESERVED
- 0:          Transmitter Enable (TxEN) - enables transmitter (should be done after the complete configuration of the transmitter)

# LEON3FT Microcontroller

## 32.4.5 Status Register

Table 348. 0x84 - STAT - Status register (read-only)

31	RESERVED	2	1	0
		BUSY	READY	
	0	1	0	
	r	r	r	

- 31: 2        RESERVED
- 1:         Busy with octet (BUSY) - External busy signal
- 0:         Ready for packet (READY) - External ready signal

## 32.4.6 Configuration Register

Table 349. 0x88 - CONF - configuration register (read-only)

31	24	23	8	7	0
REVISION			FIFOSIZE	RESERVED	
*			*	0	
r			r	r	

- 31: 24        (REVISION) - Revision number (read-only)
- 23: 8        (FIFOSIZE) - FIFO size in bytes (read-only)
- 7: 0         RESERVED

## 32.4.7 Physical Layer Register

Table 350. 0x8C - PLR - physical layer register

31	20	19	8	7	6	5	4	3	2	0
HALFBAUD	RESERVED		BUSY POS	READY POS	VALID POS	CLK RISE	CLK MODE	RESERVED		
1	0		0	1	1	1	0	0		
rw	r		rw	rw	rw	rw	rw	r		

- 31: 20        (HALFBAUD) - System clock division factor (indicates the width of the high and low phases of the outgoing PacketWire bit clock in number of system clock periods -1)
- 19: 8        RESERVED
- 7:            (BUSYPOS) - Positive polarity of busy input signal
- 6:            (READYPOS) - Positive polarity of ready input signal
- 5:            (VALIDPOS) - Positive polarity of valid output signal
- 4:            (CLKRISE) - Rising clock edge in the middle of the serial data bit
- 3:            (CLKMODE) - 0=when valid (default), 1=always (experimental)
- 2: 0         RESERVED

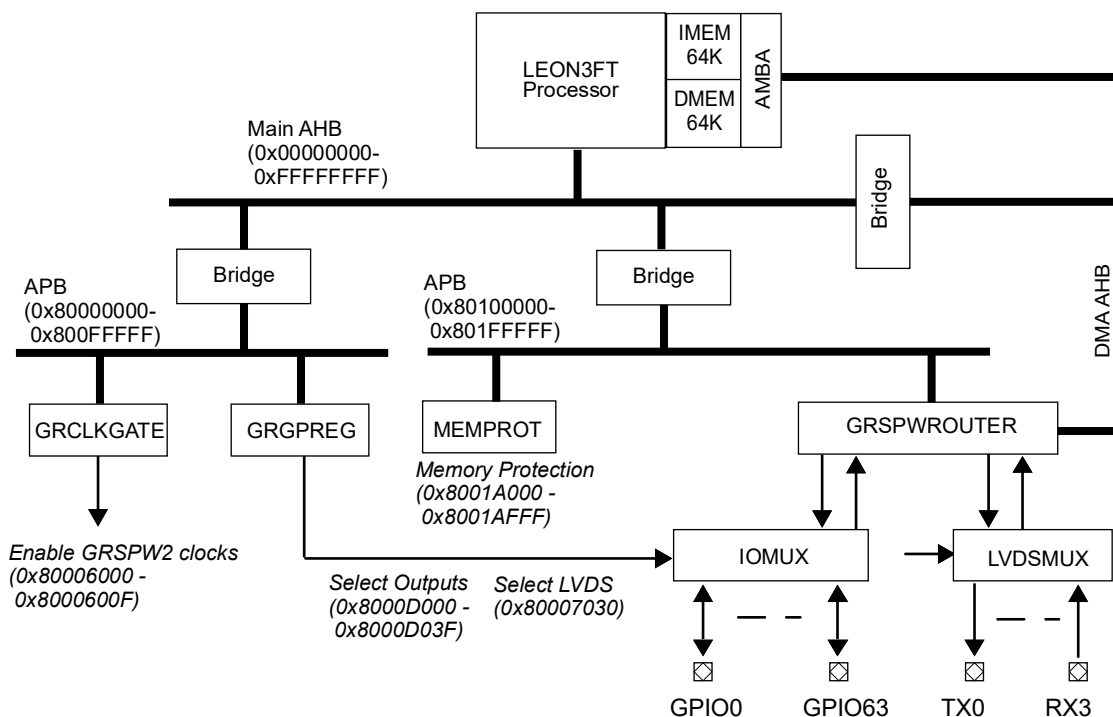
# LEON3FT Microcontroller

## 33 SpaceWire router

The GR716B microcontroller comprises a SpaceWire router with RMAP support (GRSPWROUTER) units. The SpaceWire interface with RMAP controls its own external pins and has a unique AMBA address described in chapter 2.10. The nominal SpaceWire interface is connected via LVDS transceivers to external pins and the redundant interface is connected to external pins via the IOMUX.

The SpaceWire router interface control and status registers are located on APB bus in the address range from 0x80100000 to 0x80100FFF. See GRSPWROUTER unit connections in the next drawing. The figure shows memory locations and functions used for GRSPWROUTER configuration and control.

Figure 60. GR716B 2-port GRSPWROUTER internal bus and external pin connection



The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the SpaceWire Router interface. The unit **GRCLKGATE** can also be used to perform reset of the SpaceWire router interface. Software must enable clock and release reset described in section 27 before configuration and transmission can start.

External IO selection and configuration is made in the system IO and LVDS configuration registers (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F and 0x80007030. See section 7.1 for further information.

The system can be configured to protect and restrict access to the SpaceWire router in the **MEMPROT** unit. See section 47 for more information.

### 33.1 Overview

The SpaceWire router implements a SpaceWire routing switch as defined in the ECSS-E-ST-50-12C standard. The configuration port provides an RMAP target, and an optional AMBA AHB slave interface, both used for accessing internal configuration and status registers.

Among the features supported by the router are: group adaptive routing, packet distribution, system time-distribution, distributed interrupts, port timers to recover from deadlock situations, and SpaceWire-D [SPWD] packet truncation based time-slot violations.

# LEON3FT Microcontroller

The SpaceWire router in GR716B device implements a 3-port bypass routing mode for support of multiple cascade coupled devices. The 3-port bypass routing mode implements an easy way of filter out packets intended for the GR716B device and to forward all other packets in the hardware. Filtering is enabled by configuring and using logical addresses:

- GR716B router can have one logical address in the range 32 to 223
- Packets received with the logical address of the GR716B device will be routed the AMBA-port
- Packets with logical addressing will be routed according to:
  - Packets incoming on SPW-port 1 and have a different logic address is routed to SPW-port 2
  - Packets incoming on SPW-port 2 and have a different logic address is routed to SPW-port 1
  - Packets incoming on the AMBA-port and have a lower logic address (compared to the configured) is routed to SPW-port 1. A packet with a higher logic address is routed to SPW-port 2

Note: LVDS drivers that are not used in the application can be turned off to save power. This is controlled via the register bank interface. Note that there is no automatic turning off of the LVDS drivers of disabled or inactive SpaceWire links in this device, so this must be managed by the application software.

## 33.2 Operation

The switch matrix can connect any input port to any output port. Access to each output port is arbitrated using a round-robin arbitration scheme based on the address of the incoming packet. A single routing-table is used for the whole router, where access to the table is arbitrated using a round-robin scheme based on the input port number.

The ports consist of configuration port 0, and two different types of external ports: SpaceWire links and AMBA interfaces. All ports have the same interface to the switch matrix and behave in the same manner. The difference in behavior is on the external side of the port. The SpaceWire ports provide standard SpaceWire link interfaces using on-chip LVDS. The AMBA ports transfer characters from and to an AHB bus using DMA. The different port types are described in further detail in sections 33.3, 33.4 and 33.5.

### 33.2.1 Port numbering

The router's ports are numbered as follows: configuration port has port number 0, the SpaceWire ports have port numbers 1-2, and the AMBA ports have port numbers 3.

### 33.2.2 Routing table

A single routing table is provided. The access to this routing table is arbitrated using a round-robin arbiter with each port being of equal priority. The operation is pipelined and one lookup can be done each cycle. This way the maximum latency is equal to the number of ports in the router minus one. The impact on throughput should be negligible provided that packets are not incoming at the same time. The probability for this is higher when the traffic only consist of very small packets sent continuously (the average size being about the same as the number of ports). This should be a very uncommon case. Latency is still bounded and probably negligible in comparison to other latencies in most systems.

Since the latency for the lookup is very small and deterministic there is not much to gain by having configurable priorities for this. Priorities are instead used for arbitrating packets contending for an output port as described in the next section.



# LEON3FT Microcontroller

The routing table and all the configuration registers are configured through an RMAP target or an AHB slave interface which use the same routing table as the logic handling packet traffic. They do not introduce any extra latency for packets, since the configuration accesses have lower priority than the packet traffic and thus are only allowed access on cycles when no lookup is needed for packets. This can slow down configuration accesses but they are probably mostly done before packet traffic starts and very seldom afterwards. The routing table is split into two parts, one which controls the port mapping for the address (RTR.RTPMAP registers), and one which controls properties for the address, such as priority and header deletion (RTR.RTACTRL registers).

The SpaceWire router has 4 (0 - 3) path address entries, and 224 (32 - 255) logic address entries in the routing table. Path address routes directly to corresponding port, and logic addresses can be used to route packets using single address by configuring the routing table. By default all logic addresses are disabled and sending packets with logical address will result in an individual address error. For the GR716B device only one logical address in the rang 32 to 255 can be configured and used. Hence the routing table for address 32 to 255 has been replaced with a register containing only one mapping (the one to the AMBA port). It shall be noted that all logical entries exists in the memory map to maintain the register compatibility with other SpaceWire router products and software. For detailed information about routing table configuration registers see Table 381 and Table 382.

### 33.2.2.1 Port mapping

For both physical and logical addresses it is possible to configure which port(s) the incoming packet should be routed to. This is done by programming the corresponding RTR.RTPMAP register. The RTR.RTPMAP registers also controls whether or not group adaptive routing or packet distribution should be used for the incoming packet. The RTR.RTPMAP registers are not initialized after reset / power-up. For physical addresses this has the effect that the incoming packet is routed to the port that matches the address in the packet, without any group adaptive routing or packet distribution. For logical addresses, an uninitialized RTR.RTPMAP register (or if the RTR.RTPMAP.PE field has been written with all zeros) has the effect that the incoming packet is spilled. See table 381 in section 33.6 for more details.

### 33.2.2.2 Address control

For both physical and logical addresses it is possible to configure the priority, and to enable the spill-if-not-ready feature (explained in section 33.2.8). For logical addresses it is also possible to enable / disable the address, and enable / disable header deletion. Physical addresses are always enabled, and always have header deletion enabled, as specified by ECSS-E-ST-50-12C [SPW]. This configuration for an address is done by programming the corresponding RTR.RTACTRL register. Logical addresses are disabled after reset / power-up. An incoming packet with a disabled logical address is spilled. See table 382 in section 33.6 for details.

### 33.2.3 Output port arbitration

Each output port is arbitrated individually based on the address of the incoming packet, using two priority levels, with round-robin at each level. Each physical address and logical address can be configured in the routing table (RTR.RTACTRL register) to be either high or low priority. Priority assignments can have large impact on the delays for packets, because packets can be large and the speed of the data consumer and link itself may not be known. This should therefore be considered when assigning priorities.

### 33.2.4 Group adaptive routing

Group adaptive routing can be used to allow incoming packets to be sent on different output ports depending on which of the output ports that are currently ready. It can be enabled for both physical and logical addresses, and is configured by programming the corresponding RTR.RTPMAP register.

# LEON3FT Microcontroller

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When a packet arrives, and group adaptive routing is enabled for the packet's address, the router looks at the group of ports selected by the corresponding RTR.RTPMAP register and transmits the packet on the port with the lowest index that is currently ready. Ready in this context means that the port's link interface is in run-state and currently not sending any other packet. If none of the selected output ports are ready, the incoming packet will either be spilled or transmitted on the first port that becomes ready. The action taken depends on the setting of the input port's data character timer (see section 33.2.13), the spill-if-not-ready feature for the address (see section 33.2.8), and the link-start-on-request feature for the output ports (see section 33.2.11). See table 381 in section 33.6 for details on how to enable and configure group adaptive routing.

## 33.2.5 Packet distribution

Packet distribution can be used to implement multicast and broadcast addresses, and can be enabled for both physical and logical addresses. Packet distribution is enabled and configured by programming the corresponding RTR.RTPMAP register.

When a packet arrives, and packet distribution is enabled for the packet's address, the router looks at the group of ports selected by the corresponding RTR.RTPMAP register. If all of the selected ports are ready, the packet is transmitted on all the ports. Ready in this context means that the port's link interface is in run-state and currently not sending any other packet. If one or more of the selected ports are not ready, the incoming packet will either be spilled or transmitted once all ports are ready. The action taken depends on the setting of the input port's data character timer (section 33.2.13), the spill-if-not-ready feature for the address (section 33.2.8), and the link-start-on-request feature for the output ports (section 33.2.11). See table 381 in section 33.6 for details on how to enable and configure packet distribution.

## 33.2.6 Port disable

A port can be disabled for data traffic by setting the corresponding RTR.PCTRL.DI bit. Incoming packets on a disabled port are silently spilled, and no packets are routed to a disabled port. A disabled port will not be included in any group used for group adaptive routing or packet distribution, even if the corresponding bit in that address' RTR.RTPMAP.PE field is set. When routing packets that are incoming on other ports, the router will simply behave as if the disabled port did not exist. The RTR.PCTRL.DI bit only affects routing of data, thus the transmission and reception of time-codes and distributed interrupt codes are not affected.

The link interface for a SpaceWire port is not affected solely by the RTR.PCTRL.DI bit. However, note that the RTR.PCTRL.DI bit, together with the RTR.PCTRL.LD bit, is used to clock-gate a SpaceWire port (see section ).

## 33.2.7 Static routing

The router supports a feature called static routing, which can be enabled individually per port. When enabled, all incoming packets on the port are routed based on the physical address specified in the port's RTR.PCTRL2.SC field, and the setting of the corresponding RTR.PCTRL2.SC bit, instead of the address in the packets. Header deletion is not used for the incoming packets when static routing is enabled, which means that the first byte of the packets are always sent to the output port as well. Static routing to port 0 is not allowed, and will generate an invalid address error if attempted.

The STATICROUTEEN signal works as a global enable / disable for the static routing feature during reset. The feature is enabled if the signal is high during reset, and disabled if the signal is low during reset. The RTR.RTRCFG.SR bit shows if the static routing feature is globally enabled or disabled.

Note that when static routing is enabled for a port, it is not possible to access the configuration port from the same port.

### 33.2.8 Spill-if-not-ready

The spill-if-not-ready feature can be enabled individually for each physical and logical address by configuring the corresponding RTR.RTACTRL.SR bit. When enabled, an incoming packet is spilled if the selected output port's link interface is not in run-state. If group adaptive routing is used for the incoming packet then the packet is only spilled if none of the ports in the group is in run-state. If packet distribution is used for the incoming packet then the packet is spilled unless the link interfaces for all selected output ports are in run-state. The spill-if-not-ready feature has priority over the incoming port's data character timer (section 33.2.13) and the output port's link-start-on-request feature (section 33.2.11). This means that if the spill-if-not-ready feature is enabled, the packet is spilled before the timer starts, and the link-start-on-request feature will never be activated.

### 33.2.9 Self addressing

Self addressing occurs when a selected output port for a packet is the same port as the input port. Whether or not this is allowed is controlled by the RTR.RTRCFG.SA bit. If self addressing is not allowed, the incoming packet is spilled and an invalid address error occurs.

When group adaptive routing is used, and self addressing is not allowed, the input port is still allowed to be in the group of ports configured for the packet. The packet is not spilled until the router actually selects the input port as output port. If the router selects one of the other ports in the group, the packet is not spilled.

When packet distribution is used, and self addressing is not allowed, the input port is not allowed to be in the group of ports configured for the packet, since the packet should be sent to all ports in the group.

### 33.2.10 Invalid address error

An invalid address error occurs under the conditions listed below.

- When an incoming packet's address corresponds to a non-existing port (physical addresses 20-31).
- When an incoming packet's address is a logical address that is not enabled (RTR.RTACTRL.EN = 0).
- When an incoming packet's address is a logical address for which the corresponding RTR.RTPMAP register is not initialized, or the corresponding RTR.RTPMAP.PE field set to all zeroes.
- When only one output port is selected for an incoming packet, and that port is disabled (RTR.PCTRL.DI = 1).
- When self addressing occurs, and the router is configured not to allow self addressing (RTR.RTRCFG.SA = 0).
- When a packet is routed with the static routing feature, and the physical address programmed in RTR.PCTRL2.SD is 0 (static routing to port 0 is not allowed).

For all the invalid address cases above, the incoming packet is spilled, and the RTR.PSTS.IA bit corresponding to the input port will be set to 1.

### 33.2.11 Link-start-on-request

The link-start-on-request feature gives the possibility to automatically start a SpaceWire port's link interface when a packet is routed to the port (i.e, port is selected as output port). Each port can have the feature individually enabled by setting the corresponding RTR.PCTRL.LR bit to 1.

If a packet arrives, and the link interface of the selected output port is not in run-state, and the port has the link-start-on-request feature enabled, the router will try to start the link interface under the following conditions:

# LEON3FT Microcontroller

1. The link interface is not already trying to start ( $RTR.PCTRL.LS = 0$ ).
2. The link is not disabled ( $RTR.PCTRL.LD = 0$ ).
3. The spill-if-not-ready feature is not enabled for the packet being routed.

The link will continue to be started until either the  $RTR.PCTRL.LD$  bit is set to 1, or until the link is disabled through the auto-disconnect feature, described in section 33.2.12.

The link-start-on-request feature is only available for the SpaceWire ports, since the configuration port and AMBA ports does not have a link interface FSM, and are therefore always considered to be in run-state.

### 33.2.12 Auto-disconnect

The auto-disconnect feature gives the possibility to automatically disable the link interface of a SpaceWire port if the port has been inactive for a long enough period of time. Each port can have the feature individually enabled by setting their corresponding  $RTR.PCTRL.AD$  bit to 1. The amount of time the port needs to be inactive for is decided by the settings of the global prescaler register ( $RTR.PRESCALER$ ), and the port's individual timer register ( $RTR.PTIMER$ ). This time period is the same as the timeout period used by the port's data character timer when recovering from deadlock situations (see section 33.2.13). If the auto-disconnect feature is enabled, then a SpaceWire port will automatically disable its link interface under the following conditions:

1. The link interface entered run-state because it was started by the link-start-on-request feature, described in section 33.2.11.
2. The packet that caused the link interface to start has finished (either sent or spilled).
3. Nothing has been transmitted or received on the port for the duration of the time period specified by the  $RTR.PRESCALER$  register, and the corresponding  $RTR.PTIMER$  register.
4. The port's corresponding  $RTR.PCTRL.LS$  bit has not been set to 1.

The auto-disconnect feature is only available for the SpaceWire ports, since the configuration port and AMBA ports does not have a link interface FSM, and are therefore always considered to be in run-state.

### 33.2.13 Port data character timers

Each port has an individual data character timer, which can be used to timeout an ongoing data transfer in order to recover from a deadlock situation. There are two different timeouts defined: overrun timeout, and underrun timeout. An overrun timeout is when the input port has data available, but the output port(s) can not accept data fast enough. An underrun timeout is when the output port(s) can accept more data, but the input port can not provide data fast enough.

The timeout period for a port is set in its corresponding  $RTR.PTIMER$  register, and the timer is enabled through the corresponding  $RTR.PCTRL.TR$  bit. Timeouts due to overrun and underrun can also be individually enabled / disabled through the corresponding  $RTR.PCTRL2.OR$  and  $RTR.PCTRL2.UR$  bits.

It is always the input port's data character timer that is used for timing data transfers. When the timer is enabled, it counts down on every tick from the global prescaler ( $RTR.PRESCALER$  register). If a data character is transmitted from the input port to the output port(s), then the timer is restarted. If the timer expires, the ongoing packet is spilled, and an EEP is written to the transmit FIFO of the output port(s).

The range of the timeout period depends on the system clock frequency, and is calculated with the following formula:

$$\langle \text{timeout period} \rangle = (\langle \text{clock period} \rangle \times (RTR.PRESCALER + 1)) \times RTR.PTIMER$$

Sub-sections 33.2.13.1 through 33.2.13.4 clarifies the behaviour of the timers for different scenarios that can occur when a packet arrives.

### 33.2.13.1 Timer disabled

If the data character timer for an input port is disabled, the incoming packet will wait indefinitely for the output port(s) to be ready, unless the spill-if-not-ready feature is enabled for the packet's address (see section 33.2.8).

### 33.2.13.2 Timer enabled, but output port(s) not in run state

If the spill-if-not-ready feature (see section 33.2.8) is disabled for the incoming packet's address, the input port's data character timer is started when the packet arrives, and if the output port's link interface has not entered run-state when the timer expires, the packet is spilled. When group adaptive routing is used for the incoming packet, it is enough for one of the possible output ports to enter run-state before the timer expires for the packet to be transmitted. If packet distribution is used, all the output ports must enter run-state before the timer expires, otherwise the packet is spilled.

If the link-start-on-request feature is enabled for an output port, that port will try to enter run-state when the packet arrives. However, the input port's timer is unaffected of this, and will still only wait for its configured timeout period, before spilling the packet.

A timeout due to the output port not being in run-state is classified as a overrun timeout, which means that the RTR.PCFG2.OR bit for the input port must be set in order for the packet to be spilled. If the RTR.PCFG2.OR bit is not set, the packet will wait indefinitely (unless spill-if-not-ready is enabled).

### 33.2.13.3 Timer enabled, output port(s) in run-state but busy with other transmission

The input port's data character timer will not start, and the incoming packet will wait indefinitely until the output port either becomes free or leaves run-state. When group adaptive routing is used for the incoming packet, it is enough for one of the possible output ports to be in run-state to prevent the timer from starting. If packet distribution is used, all the output ports must be in run-state to prevent the timer from starting.

### 33.2.13.4 Timer functionality when accessing the configuration port

The timer functionality is basically the same for the configuration port as for the other ports. When the command is being received, the configuration port is the output port of the data transfer, and when the reply is being sent, the configuration port is the input port of the data transfer. The differences between the configuration port and the other ports are:

- The configuration port can always accept data fast enough, which means that an overrun timeout will never occur when a command is being received.
- The configuration port can always send data fast enough, which means that an underrun timeout will never occur when a reply is being sent.

### 33.2.14 Packet length truncation

Packet length truncation monitors the length of an incoming packet, and increases a counter for each received data character. If the counter reaches a value larger than the input port's RTR.MAXPLEN register, and truncation is enabled for the input port (RTR.PCTRL.PL = 1), the rest of the packet is spilled, and an EEP is written to the FIFO of the output port(s). Each port has its own RTR.MAXPLEN register and counter in order to allow different maximum lengths for different ports.

Packet length truncation can also be enabled for port 0. In that case, it is the length of the RMAP / SpaceWire Plug-and-Play reply packet that is monitored.

### 33.2.15 System time-distribution

The router supports system time distribution through time-codes, as defined in ECSS-E-ST-50-12C [SPW]. It contains a global time-counter register (RTR.TC) where the latest received time-code can be read. Both the SpaceWire ports and the SIST port support time-code transmission and reception.

# LEON3FT Microcontroller

All incoming time-codes update the RTR.TC register. If the incoming time-code has a time value which is plus one (modulo 64) compared to the old RTR.TC value, the time-code is forwarded to all the other ports. The time-code is not sent out onto the port on which it arrived.

Time-codes can be globally enabled / disabled through the RTR.TC register, as well as individually enabled / disabled per port through respective RTR.PCTRL.TE bit. When time-codes are disabled for a port, all incoming time-codes on that port are discarded, and no time-codes will be forwarded to the port.

The router can be configured to either filter out all incoming time-codes that does not have the two control flags (bit 7:6) set to “00”, or to discard the control flags and allow them to have any value. This configuration is done through the RTR.RTRCFG.TF bit. The value of the control flags for the last received time-code can also be read from the RTR.TC register. Note that if interrupt distribution is globally enabled (RTR.RTRCTRL.IE = 1), only control flags “00” are considered as time-codes, no matter the value of the RTR.RTRCFG.TF bit.

## 33.2.16 SpaceWire distributed interrupt support

The router supports SpaceWire distributed interrupts. It can be configured to operate in two modes, interrupt with acknowledgment mode and extended interrupt mode. In the interrupt with acknowledgment mode, 32 interrupt numbers are supported, whereas the extended interrupt mode supports 64 interrupt numbers. The operation mode is configured through the RTR.RTRCFG.EE bit.

A distributed interrupt code is a control code that has the control flags (bits 7:6) always set to “10”.

- *Interrupt with acknowledgment mode:* A distributed interrupt code that has bit 5 set to 0 is called an interrupt code, and bits 4:0 specify an interrupt number between 0 and 31. When operating in the interrupt with acknowledgment mode, a distributed interrupt code with bit 5 set to 1 is called an interrupt acknowledgment code, which is used to acknowledge the interrupt with the interrupt number specified by bits 4:0.
- *Extended interrupt mode:* When operating in the extended interrupt mode, a distributed interrupt code with bit 5 set to 1 is called an extended interrupt code, and bits 4:0 specify an interrupt number between 32 and 63. If bit 5 is set to 0, bits 4:0 specify an interrupt number between 0 and 31.

The interrupt codes and extended interrupt codes are generated by the source of the interrupt event, while the interrupt acknowledgment code is sent by the interrupt handler for the corresponding interrupt number.

The router has two 32-bit ISR register (RTR.ISR0 and RTR.ISR1) where each bit corresponds to one interrupt number. A bit in the ISR registers is set to 1 when an interrupt code or extended interrupt code with the corresponding interrupt number is received. A bit in the ISR registers is set to 0 when an interrupt acknowledgment code with the corresponding interrupt number is received. Therefore, the ISR registers reflect the status of all interrupt numbers. Each interrupt number has also its own timer which is used to clear the ISR register bit if an interrupt acknowledgment code is not received before the timer expires (for example if operating in the extended interrupt mode), as well as an optional timer which is used to control how fast a bit in the RTR.ISR register is allowed to toggle. See section 33.2.16.2 for more details on the ISR timers. Note that although it is possible to clear the bits in the ISR registers, these registers should normally only be used for diagnostics and FDIR.

### 33.2.16.1 Receiving and transmitting distributed interrupt codes

When a distributed interrupt code is received on a port, or the auxiliary time-code / distributed interrupt code interface, the following requirements must be fulfilled in order for the code to be distributed:

1. Interrupt distribution is globally enabled (RTR.RTRCTRL.IE = 1), and enabled for the port that received the code (corresponding RTR.PCTRL.IC = 1).

2. If the received code is an interrupt code, the RTR.PCTRL2.IR bit for the port must be set to 1. If the received code is an interrupt acknowledgement code or extended interrupt code, the RTR.PCTRL2.AR bit for the port must be set to 1.
3. If the code is an interrupt code or extended interrupt code, the interrupt number's corresponding bit in RTR.ISR0 or RTR.ISR1 must be 0. If the code is an interrupt acknowledgement code, the corresponding bit in RTR.ISR0 must be 1.
4. No previous distributed interrupt code with the same interrupt number is waiting to be distributed.
5. The ISR change timers (see section 33.2.16.2) are either globally disabled (RTR.RTRCFG.IC = 0) or the interrupt number's corresponding ISR change timer has expired.

If one of the requirements above is not fulfilled, then the received code is discarded. If all of the requirements above are fulfilled, then the received code is placed in a queue. The queue is then serviced in one of the four following ways, depending on the settings of the RTR.RTRCFG.IS and RTR.RTRCFG.IP bits:

1. All interrupt codes have priority over all interrupt acknowledgement codes / extended interrupt codes (RTR.RTRCFG.IP = 0), and the interrupt numbers are serviced through a round-robin scheme (RTR.RTRCFG.IS = 0). This is the default service scheme after reset / power-up.
2. All interrupt codes have priority over all interrupt acknowledgement codes / extended interrupt codes (RTR.RTRCFG.IP = 0), and the interrupt numbers are serviced with priority to lower interrupt numbers (RTR.RTRCFG.IS = 1).
3. All interrupt acknowledgement codes / extended interrupt codes have priority over all interrupt codes (RTR.RTRCFG.IP = 1), and the interrupt numbers are serviced through a round-robin scheme (RTR.RTRCFG.IS = 0).
4. All interrupt acknowledgement codes / extended interrupt codes have priority over all interrupt codes (RTR.RTRCFG.IP = 1), and the interrupt numbers are serviced with priority to lower interrupt numbers (RTR.RTRCFG.IS = 1).

When a distributed interrupt code has been selected from the queue, it is forwarded to all ports (except the port it was received on) that has interrupt distribution enabled (RTR.PCTRL.IC = 1), and that has enabled transmission of interrupt codes or interrupt acknowledgement codes / extended interrupt codes (RTR.PCTRL2.IT and RTR.PCTRL2.AT respectively).

### 33.2.16.2 Interrupt distribution timers

Each interrupt number has two corresponding timers, called the ISR timer, and ISR change timer:

The ISR timer is started and reloaded with the value from the RTR.ISRTIMER register each time a received interrupt code / extended interrupt code sets the corresponding RTR.ISR0 / RTR.ISR1 bit to 1. If an interrupt acknowledgement code is received, the corresponding ISR timer is stopped. If the ISR timer expires before an interrupt acknowledgement code is received, the corresponding bit in the RTR.ISR0 or RTR.ISR1 register is cleared. The use of ISR timers is always enabled. In the interrupt with acknowledgement mode, the purpose of the timers is to recover from situations where an interrupt acknowledgement code is lost. In the extended interrupt mode, the purpose of the ISR timers is to limit the rate of which interrupt codes are forwarded. It is important to configure the reload value for the ISR timer correctly. In the interrupt with acknowledgement mode, the reload value must not be less than the worst propagation delay for the interrupt code, plus the maximum delay in the interrupt handler, plus the worst propagation delay for the interrupt acknowledgement code. In the extended interrupt mode, the reload value must not be less than the worst propagation delay for the interrupt code / extended interrupt code.

The ISR change timers are timers that optionally can be used to control the minimum delay between two consecutive changes to the same RTR.ISR0 / RTR.ISR1 bit. The purpose of the timers is to protect against unexpected code occurrences that could occur, for example, due to a network malfunction or a babbling idiot. If the use of ISR change timers is enabled (RTR.RTRCFG.IC = 1), then the ISR

# LEON3FT Microcontroller

change timer for an RTR.ISR0 / RTR.ISR1 bit is started and reloaded with the value from the RTR.ISRCTIMER register each time a received distributed interrupt code makes the RTR.ISR0 / RTR.ISR1 bit change value. Until the timer has expired, the corresponding RTR.ISR0 / RTR.ISR1 bit is not allowed to change value, and any received distributed interrupt code with that interrupt number is discarded. In the extended interrupt mode, the ISR change timers are not used, and should be disabled.

### 33.2.16.3 Interrupt code generation

In addition to distributing interrupt codes received on the ports, the router can also generate an interrupt code / extended interrupt code when an internal error event occurs, such that the IRQ pin is set to 1. See section 33.2.20 for information about how to control which errors that set the IRQ pin. In addition to the errors described in 33.2.20 the IRQ pin can also be configured to be set when a SpaceWire port's link interface enters run-state.

Everything in sections 33.2.16.1 and 33.2.16.2 also applies when the distributed interrupt code is generated by the router. The only difference is that a distributed interrupt code generated by the router will not be discarded if it is not allowed to be distributed. Instead, the distributed interrupt code will be distributed later, as soon as it is allowed. The only time a distributed interrupt code generated by the router is not distributed is if the bits in RTR.PIP are cleared by software before the interrupt code is allowed to be sent.

The interrupt code generation is controlled through the RTR.ICODEGEN register, and in addition to the enable / disable bit (RTR.ICODEGEN.EN), the following features are available:

- The interrupt number to use for a generated distributed interrupt code is programmable through the RTR.ICODEGEN.IN field.
- The generated distributed interrupt code can be configured to be either level type, or edge type. Level type means that a new distributed interrupt code will be sent as long as the IRQ pin is set (i.e. as long as any bit in the RTR.PIP register is set). Edge type means that a new distributed interrupt code will only be sent when a new error event occurs (an RTR.PIP bit toggles from 0 to 1). The type is selected by the RTR.ICODEGEN.IT bit.
- A timer can be enabled through the RTR.ICODEGEN.TE bit. This timer controls the minimum time between a received interrupt acknowledgement code and the distribution of a new generated interrupt code. The timer is started and reloaded with the value from the RTR.AITIMER register when an interrupt acknowledgement code is received, if the router was the source of the corresponding interrupt code. Until the timer has expired, a new generated interrupt code will not be distributed. The reload value should not be less than the worst propagation delay for the interrupt acknowledgement code. This timer is unused when operating in the extended interrupt mode.
- Through the RTR.ICODEGEN.AH and RTR.ICODEGEN.UA bits the router can be configured to, upon receiving an interrupt acknowledgement code, or the when the ISR timer expires, automatically clear the RTR.PIP bits that were set when the distributed interrupt code was generated.

### 33.2.17 Auxiliary time-code / distributed interrupt code interface

The router provides an auxiliary time-code / distributed interrupt code interface that is connected internally to the SpaceWire TDP controller.

The rules that determine whether a distributed interrupt code should be forwarded to the ports are the same as when a distributed interrupt code is received from any other port. However, for time-codes, the value on AUXTIMEIN[7:0] is always forwarded, and the router's internal time-count value is updated. Note that time-codes / distributed interrupt codes received through the auxiliary interface is not forwarded back out onto the interface itself.

Just as for the router ports, the auxiliary interface has enable / disable bits for time-codes (RTR.RTRCFG.AT) and distributed interrupt codes (RTR.RTRCFG.AI), which need to be set high in order for respective code to be transmitted / received.



### 33.2.18 SpaceWire-D support

#### 33.2.18.1 Time-code / distributed interrupt code truncation

The router supports truncation of packets when it receives a valid time-code / distributed interrupt code (time-code or distributed interrupt code). A time-code is considered valid when the value equals the internal time count plus one (modulo 64). An distributed interrupt code is considered valid if the corresponding ISR bit is flipped due to reception of the code. The feature can be enabled individually for each port by setting the corresponding RTR.PCTRL.TS bit to 1. A filter, allowing only certain time-codes / distributed interrupt codes to spill packets, can also be configured individually for each port (see RTR.PCTRL2 register).

If a packet transfer is ongoing when a valid time-code / distributed interrupt code is received, and the code matches the filter in RTR.PCTRL2, the rest of the packet is spilled, and an EEP is written to the FIFO of the output port(s).

Time-code / distributed interrupt code truncation can also be enabled for port 0. In that case, it is the RMAP / SpaceWire Plug-and-Play reply packet that is spilled.

### 33.2.19 Character and packet counters

Each port, except port 0, has counters for incoming and outgoing characters and packets. For the character counters (RTR.ICHARCNT / RTR.OCHARCNT registers), only SpaceWire data characters are counted (not EOP/EEP). Characters deleted due to header deletion are counted on the incoming port but not on the outgoing port. For the packet counters (RTR.IPKTCNT / RTR.OPKTCNT registers), each EOP/EEP that is preceded by at least one data character is counted as a packet. The counters wrap around, and signal an overflow, when they reach the maximum value. The counters are accessed through the configuration port. See section 33.6 for details.

### 33.2.20 Error detection and reporting

The router can detect and report the following errors:

- SpaceWire link errors: parity error, disconnect error, escape error, credit error (see ECSS-E-ST-50-12C [SPW] for definition of these errors).
- Packet spill due to: timeout (see section 33.2.13), packet length truncation (see section 33.2.14), time-code / distributed interrupt code truncation (see section 33.2.18.1), and spill-if-not-ready feature (see section 33.2.8)
- Invalid address error (see section 33.2.10)
- RMAP errors (see section 33.5.1)
- Memory errors in the memory used for the routing table, RMAP command buffers, and port transmit and receive FIFO (see section 33.2.22)
- SpaceWire Plug-and-Play errors (see section 33.6.1)

Each error type has corresponding status bits in respective RTR.PSTS register (RTR.PSTSCFG for the configuration port). Common for all the status bits is that they are set when the error is detected, and stay set until they are cleared manually.

Another way the router can report an error is to asserted the IRQ pin. Whether or not the IRQ pin is set when one of the above mentioned errors occur is controlled by the two mask registers, RTR.IMASK and RTR.IPMASK. When the error occur and both the port's corresponding bit in RTR.IPMASK as well as the error type's corresponding bit in RTR.IMASK, are set, then the port's corresponding bit in the Port interrupt pending register (RTR.PIP) is set. The IRQ pin is high as long as any bit in the RTR.PIP register is set.

The router can also be configured to generate a distributed interrupt code when the IRQ pin gets set. See section 33.2.16 for more details.

### 33.2.21 Setting link-rate for the SpaceWire ports

The initialization divisor register (RTR.IDIV) determines the link-rate during initialization (all states up to and including the connecting-state) for all SpaceWire ports. The register is also used to calculate the link interface FSM timeouts for all SpaceWire ports (6.4 us and 12.8 us, as defined in the SpaceWire standard). The RTR.IDIV register should always be set so that a 10 Mbit/s link-rate is achieved during initialization. In that case the timeout values will also be calculated correctly. The reset value of the RTR.IDIV.ID field is taken from the IDIVISOR[7:0] signal, see Table 393 for details.

To achieve a 10 Mbit/s link-rate, the RTR.IDIV register should be set according to the following formula:

$$RTR.IDIV = (\text{frequency in MHz of internal SpaceWire clock} / 10) - 1$$

The link-rate in run-state can be controlled individually per SpaceWire port with the run-state divisor located in each port's control register (RTR.PCTRL.RD field). The link-rate in run-state is calculated according to the following formula:

$$\text{link-rate in Mbits/s} = \text{frequency in MHz of internal SpaceWire clock} / (RTR.PCTRL.RD + 1)$$

The value in RTR.PCTRL.RD only affects the link-rate in run-state, and does not affect the 6.4 us or 12.8 us timeout values. The reset value of the RTR.PCTRL.RD field is taken from the IDIVISOR[7:0] signal, see Table 384 for details.

### 33.2.22 On-chip memories

There are two memory blocks in the routing table, one for the port setup registers and one for the routing table. The port setup memory bit width is equal to the number of ports including the configuration port with depth 256. The routing table is 256 locations deep and 3 bits wide.

Each port excluding the configuration port also have FIFO memories. The SpaceWire ports have one FIFO per direction (rx, tx) which are 10-bit respective 9-bit wide. The FIFO ports have the exact same FIFO configuration as the SpaceWire ports.

The AMBA ports have one 9-bit wide receiver FIFO and two 32-bit wide AHB FIFOs.

Parity is used to protect the memories and up to four bits per word can be corrected and there is a signal indicating an uncorrectable error.

If a memory error occurs in the port setup table or the routing table the memory error (ME) bit in the router configuration/status register is set and remains set until cleared by the user. If a memory error is detected in any of the ports FIFO memories the memory error (ME) bit in the respective port status register is set and remains set until cleared by the user. The ME bits are only set for uncorrectable errors.

When an uncorrectable error is detected in the port setup or routing table when a packet is being routed it will be discarded. Uncorrectable errors in the FIFO memories are not handled since they only affect the contents of the routed packet not the operation of the router itself. These type of errors should be caught by CRC checks if used in the packet.

The ME bit for the ports is only usable for detecting errors and statistics since there is no need to correct the error manually since the packet has already been routed when it is detected. The ME indication for the routing table and port setup registers can be used for starting a scrubbing operation if detected.

### 33.3 SpaceWire ports

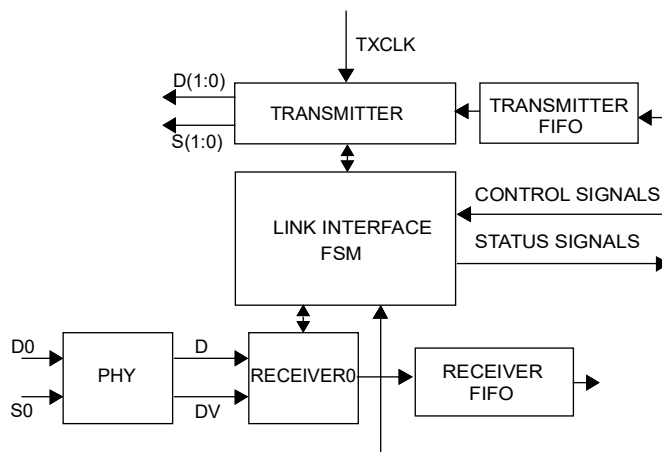


Figure 61. Block diagram

33.3.1 Each SpaceWire port comprises a SpaceWire codec that implements an encoder-decoder compliant to ECSS-E-ST-50-12C [SPW]. The interface to the router's switch matrix consists of a transmit FIFO, receive FIFO, and control and status signals, see Figure 61. The transmit and receive FIFOs can both store up to 64 N-chars. All the configuration parameters and status information for the ports are accessible through the router's configuration port, either through RMAP or AMBA AHB (see section 33.6).

#### 33.3.2 Link-interface FSM

The link-interface FSM controls the link interface (a more detailed description is found in ECSS-E-ST-50-12C [SPW]). The low-level protocol handling (the signal and character level) is handled by the transmitter and receiver while the FSM handles the exchange level.

The link-interface FSM is controlled through the control signals provided in the RTR.PCTRL registers. The link can be disabled through the RTR.PCTRL.LD bit, which depending on the current state, either prevents the link-interface from reaching the started-state, or forces it to the error-reset state. When the link is not disabled, the link interface FSM is allowed to enter the started-state when either the RTR.PCTRL.LS bit is set, or the link-start-on-request feature described in section 33.2.11 is trying to start the port, or when a NULL character has been received and the RTR.PCTRL.AS bit is set.

The current state of the link-interface determines which type of characters are allowed to be transmitted, which, together with the requests made from the host interface, determine what character will be sent.

When the link-interface is in the connecting- or run-state it is allowed to send FCTs. FCTs are sent automatically by the link-interface when possible. This is done based on the maximum value of 56 for the outstanding credit counter and the currently free space in the receive FIFO. FCTs are sent as long as the outstanding counter is less than or equal to 48, and there are at least 8 more empty FIFO entries than the counter value.

N-Chars are sent in the run-state when they are available from the transmit FIFO, and there are credits available. NULLs are sent when no other character transmission is requested, or when the FSM is in a state where no other transmission is allowed.

# LEON3FT Microcontroller

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The credit counter (incoming credits) is automatically increased when FCTs are received, and decreased when N-Chars are transmitted. The credit counter for a SpaceWire port can be read in the corresponding RTR.CREDCNT register.

### 33.3.3 Transmitter

The state of the FSM, credit counters, possible request to send a time-code / distributed interrupt code, and requests from the transmit FIFO are used to decide the next character to be transmitted. The type of character and the character itself (for N-Chars and time-codes / distributed interrupt codes) to be transmitted are presented to the low-level transmitter, which run on the internal SpaceWire clock. For information on how to change the transmission rate, please see section 33.2.21.

The state of the FSM, credit counters, requests from the time-interface and requests from the transmitter FIFO are used to decide the next character to be transmitted. The type of character and the character itself (for N-Chars and Time-codes) to be transmitted are presented to the low-level transmitter which is located in a separate clock-domain.

### 33.3.4 Receiver

The receiver is activated as soon as the link-interface leaves the error reset state. Then after a NULL is received it can start receiving any characters. It detects parity, escape and credit errors, which causes the link interface to enter the error-reset state.

Received L-Chars are the handled automatically by link-interface, while all N-Chars are stored in the receive FIFO.

The max receive rate is 1.3 times the frequency of the internal SpaceWire clock and the device has been tested for a receive bit rate of maximum 200 Mbit/s. The system clock must be higher or equal to the receive bit rate divided by eight. For example, if the receive bit rate is 100 Mbit/s then the system clock must be at least 12.5 MHz.

### 33.3.5 Setting link-rate

The router's Initialization divisor register determines the link-rate during initialization (all states up to and including the connecting-state). The register is also used to calculate the link interface FSM time-outs (6.4 us and 12.8 us, as defined in the SpaceWire standard). The register's ID field should always be set so that a 10 Mbit/s link-rate is achieved during initialization. In that case the timeout values will also be calculated correctly.

To achieve a 10 Mbit/s link-rate, the ID field should be set according to the following formulas:

With single data rate (SDR) outputs:

$$ID = (\langle \text{frequency in MHz of internal SpaceWire clock} \rangle / 10) - 1$$

The link-rate in run-state is controlled with the run-state divisor, which is set through the RD field of each port's Port control register. The link-rate in run-state is calculated according to the following formulas:

With SDR outputs:

$$\langle \text{link-rate in Mbits/s} \rangle = \langle \text{frequency in MHz of internal SpaceWire clock} \rangle / (RD + 1)$$

The value of the RD field only affects the link-rate in run-state, and does not affect the 6.4 us or 12.8 us timeouts values.

# LEON3FT Microcontroller

An example of clock divisor and resulting link-rate, with a internal SpaceWire frequency of 50 MHz, is shown in the table 351.

Table 351.SpaceWire link-rate example with 50 MHz TXCLK

Clock divisor value	Link-rate in Mbit/s
	SDR outputs
0	50
1	25
3	12.5
4	10
9	5

## 33.4 AMBA ports

The AMBA ports are Frontgrade Gaisler’s GRSPW2 controller with the SpaceWire codec removed. Thus, the same drivers that are provided for the GRSPW2 can also be used for an AMBA port of the router. Only one additional driver is needed, which handles the setup of the registers within the configuration port.

### 33.4.1 Overview

The router’s AMBA ports are configured by register accesses through an APB interface. Data is transferred through one to four DMA channels using an AHB master interface.

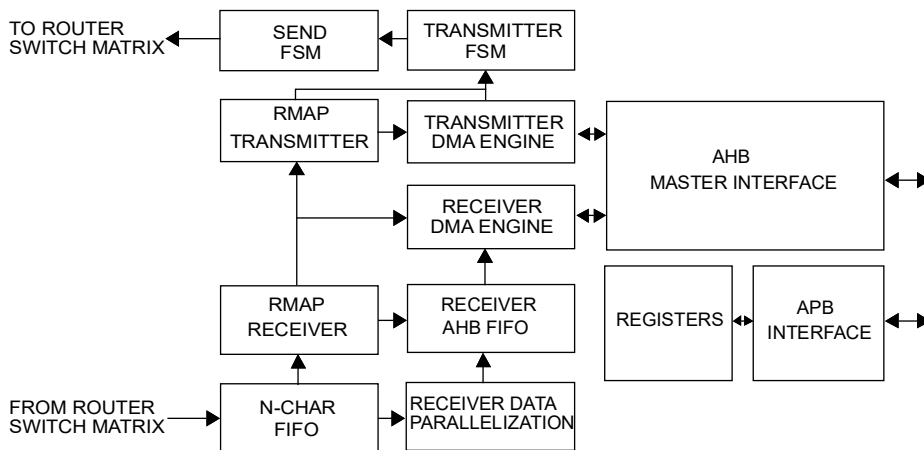


Figure 62. Block diagram of the Router DMA port

### 33.4.2 Operation

The main sub-blocks of the router AHB interfaces are the DMA engines, the RMAP target and the AMBA interface. A block diagram of the internal structure can be found in figure 62.

The AMBA interface is divided into the AHB master interface and the APB interface. The DMA engines have FIFO interfaces to the router switch matrix. These FIFOs are used to transfer N-Chars between the AMBA bus and the other ports in the router.

The RMAP target handles incoming packets which are determined to be RMAP commands instead of the receiver DMA engine. The RMAP command is decoded and if it is valid, the operation is per-

# LEON3FT Microcontroller

formed on the AHB bus. If a reply was requested it is automatically transmitted back to the source by the RMAP transmitter.

The AMBA ports are controlled by writing to a set of user registers through the APB interface and a set of signals. The different sub-modules are discussed in further detail in later sections.

### 33.4.2.1 Protocol support

The AMBA port only accepts packets with a valid destination address in the first received byte. Packets with address mismatch will be silently discarded (except in promiscuous mode which is covered in section 33.4.4.10).

The second byte is sometimes interpreted as a protocol ID as described hereafter. The RMAP protocol (ID=0x1) is the only protocol handled separately in hardware while other packets are stored to a DMA channel. If the RMAP target is present and enabled all RMAP commands will be processed, executed and replied automatically in hardware. Otherwise RMAP commands are stored to a DMA channel in the same way as other packets. RMAP replies are always stored to a DMA channel. More information on the RMAP protocol support is found in section 33.4.6 (note that this RMAP target is different from the one in the configuration port). When the RMAP target is not present or disabled, there is no need to include a protocol ID in the packets and the data can start immediately after the address.

All packets arriving with the extended protocol ID (0x00) are stored to a DMA channel. This means that the hardware RMAP target will not work if the incoming RMAP packets use the extended protocol ID. Note also that packets with the reserved extended protocol identifier (ID = 0x000000) are not ignored by the AMBA port. It is up to the client receiving the packets to ignore them.

When transmitting packets, the address and protocol-ID fields must be included in the buffers from where data is fetched. They are *not* automatically added by the AMBA port DMA engine.

Figure 63 shows the packet types accepted by the port. The port also allows reception and transmission with extended protocol identifiers but without support for RMAP CRC calculations and the RMAP target.

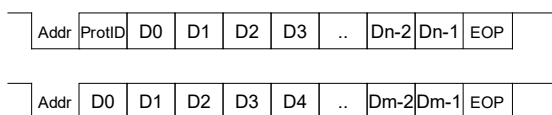


Figure 63. The SpaceWire packet types supported by the port.

### 33.4.3 Time-Code / distributed interrupt interface

#### 33.4.3.1 Sending and receiving Time-Codes

To transmit a Time-Code through the register interface of an AMBA port, the RTR.AMBACTRL.TI bit should be written to 1. When the bit is written, the AMBA port's current time value (RTR.AMBATC.TIMECNT field) is incremented and a Time-Code consisting of the new time value together with the current control flags (RTR.AMBATC.TCTRL field) is sent. The RTR.AMBACTRL.TI bit will stay high until the Time-Code has been transmitted. Note that whether or not a Time-Code is forwarded to any other port after it has been sent by an AMBA port depends on the settings explained in 33.2.15.

A Time-Code that is received by an AMBA port will be stored in the port's RTR.AMBATC register. There is also a possibility to generate AMBA interrupts and tick-out pulses. This is controlled through the RTR.AMBACTRL and RTR.AMBATC registers. See section 33.4.8 for details about these registers.

### 33.4.3.2 Sending and receiving distributed interrupts

To transmit a distributed interrupt code through the register interface of an AMBA port, the RTR.AMBAINCTRL.II bit in should be written to 1. When the bit is written, the value of the RTR.AMBAINCTRL.TXINT field determine which distributed interrupt code that will be sent. Note that whether or not a distributed interrupt code is forwarded to any other port after it has been sent by an AMBA port depends on the settings of the router and the state of that specific interrupt in the network. See 33.2.16 for details.

A distributed interrupt can also be configured to be generated automatically by the AMBA port upon certain events. This is controlled through the RTR.AMBAINCTRL and RTR.AMBADMACTRL registers. See section 33.4.8 for details about these registers and features.

Distributed interrupt codes that are received by an AMBA port can be programmed to generate AMBA interrupts as well as tick out-pulses. See section 33.4.8 for details about these features.

### 33.4.3.3 Sending and receiving Time-Codes and distributed interrupts via signal interface

For all received control codes, Time-Codes or not, the control flags together with the time value are outputted on the TIMEOUT[7:0] signals, and the TICKOUT signal is asserted for one system clock cycle.

Control codes can be sent by asserting the TICKIN signal and place the value of the Time-Code / distributed interrupt to be sent on the TIMEIN[7:0] signals.

## 33.4.4 Receiver DMA channels

The receiver DMA engine handles reception of data from the SpaceWire network to different DMA channels.

### 33.4.4.1 Address comparison and channel selection

Packets are received to different channels based on the address and whether a channel is enabled or not. When the receiver N-Char FIFO contains one or more characters, N-Chars are read by the receiver DMA engine. The first character is interpreted as the logical address and is compared with the addresses of each channel starting from 0. The packet will be stored to the first channel with an matching address. The complete packet including address and protocol ID but excluding EOP/EEP is stored to the memory address pointed to by the descriptors (explained later in this section) of the channel.

Each SpaceWire address register has a corresponding mask register. Only bits at an index containing a zero in the corresponding mask register are compared. This way a DMA channel can accept a range of addresses. There is a default address register which is used for address checking in all implemented DMA channels that do not have separate addressing enabled and for RMAP commands in the RMAP target. With separate addressing enabled the DMA channels' own address/mask register pair is used instead.

If an RMAP command is received it is only handled by the target if the default address register (including mask) matches the received address. Otherwise the packet will be stored to a DMA channel if one or more of them has a matching address. If the address does not match neither the default address nor one of the DMA channels' separate register, the packet is still handled by the RMAP target if enabled since it has to return the invalid address error code. The packet is only discarded (up to and including the next EOP/EEP) if an address match cannot be found and the RMAP target is disabled.

Packets, other than RMAP commands, that do not match neither the default address register nor the DMA channels' address register will be discarded. Figure 64 shows a flowchart of packet reception.

At least 2 non EOP/EEP N-Chars needs to be received for a packet to be stored to the DMA channel unless the promiscuous mode is enabled in which case 1 N-Char is enough. If it is an RMAP packet

# LEON3FT Microcontroller

with hardware RMAP enabled 3 N-Chars are needed since the command byte determines where the packet is processed. Packets smaller than these sizes are discarded.

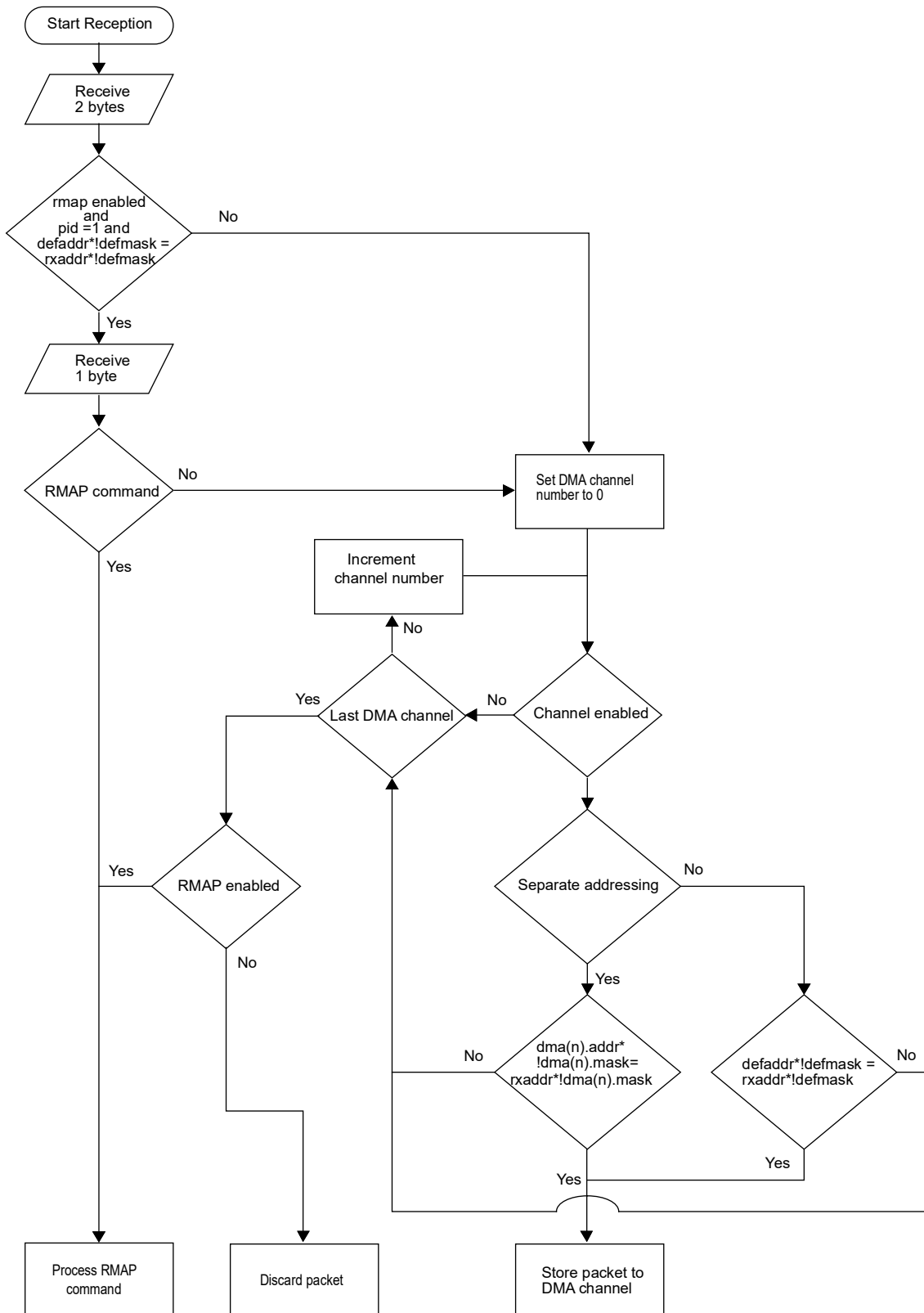


Figure 64. Flow chart of packet reception (promiscuous mode disabled).



#### 33.4.4.2 Basic functionality of a channel

Reception is based on descriptors located in a consecutive area in memory that hold pointers to buffers where packets should be stored. When a packet arrives at the port the channel which should receive it is first determined as described in the previous section. A descriptor is then read from the channels' descriptor area and the packet is stored to the memory area pointed to by the descriptor. Lastly, status is stored to the same descriptor and increments the descriptor pointer to the next one. The following sections will describe DMA channel reception in more detail.

#### 33.4.4.3 Setting up the port for reception

A few registers need to be initialized before reception to a channel can take place. The DMA channel has a maximum length register which sets the maximum packet size in bytes that can be received to this channel. Larger packets are truncated and the excessive part is spilled. If this happens an indication will be given in the status field of the descriptor. The minimum value for the receiver maximum length field is 4 and the value can only be incremented in steps of four bytes up to the maximum value 33554428. If the maximum length is set to zero the receiver will *not* function correctly.

Either the default address register or the channel specific address register (the accompanying mask register must also be set) needs to be set to hold the address used by the channel. A control bit in the DMA channel control register determines whether the channel should use default address and mask registers for address comparison or the channel's own registers. Using the default register the same address range is accepted as for other channels with default addressing and the RMAP target while the separate address provides the channel its own range. If all channels use the default registers they will accept the same address range and the enabled channel with the lowest number will receive the packet.

Finally, the descriptor table and control register must be initialized. This will be described in the two following sections.

#### 33.4.4.4 Setting up the descriptor table address

The port reads descriptors from an area in memory pointed to by the receiver descriptor table address register. The register consists of a base address and a descriptor selector. The base address points to the beginning of the area and must start on a 1024 bytes aligned address. It is also limited to be 1024 bytes in size which means the maximum number of descriptors is 128 since the descriptor size is 8 bytes.

The descriptor selector points to individual descriptors and is increased by 1 when a descriptor has been used. When the selector reaches the upper limit of the area it wraps to the beginning automatically. It can also be set to wrap at a specific descriptor before the upper limit by setting the wrap bit in the descriptor. The idea is that the selector should be initialized to 0 (start of the descriptor area) but it can also be written with another 8 bytes aligned value to start somewhere in the middle of the area. It will still wrap to the beginning of the area.

If one wants to use a new descriptor table the receiver enable bit has to be cleared first. When the rxactive bit for the channel is cleared it is safe to update the descriptor table register. When this is finished and descriptors are enabled the receiver enable bit can be set again.

#### 33.4.4.5 Enabling descriptors

As mentioned earlier one or more descriptors must be enabled before reception can take place. Each descriptor is 8 byte in size and the layout can be found in the tables below. The descriptors should be written to the memory area pointed to by the receiver descriptor table address register. When new descriptors are added they must always be placed after the previous one written to the area. Otherwise they will not be noticed.

A descriptor is enabled by setting the address pointer to point at a location where data can be stored and then setting the enable bit. The WR bit can be set to cause the selector to be set to zero when

# LEON3FT Microcontroller

reception has finished to this descriptor. IE should be set if an interrupt is wanted when the reception has finished. The DMA control register interrupt enable bit must also be set for an interrupt to be generated.

Table 352. RXDMA receive descriptor word 0 (address offset 0x0)

31	30	29	28	27	26	25	24					0
TR	DC	HC	EP	IE	WR	EN	PACKETLENGTH					

- 31 Truncated (TR) - Packet was truncated due to maximum length violation.
- 30 Data CRC (DC) - 1 if a CRC error was detected for the data and 0 otherwise.
- 29 Header CRC (HC) - 1 if a CRC error was detected for the header and 0 otherwise.
- 28 EEP termination (EP) - This packet ended with an Error End of Packet character.
- 27 Interrupt enable (IE) - If set, an interrupt will be generated when a packet has been received if the receive interrupt enable bit in the DMA channel control register is set.
- 26 Wrap (WR) - If set, the next descriptor used by the GRSPW will be the first one in the descriptor table (at the base address). Otherwise the descriptor pointer will be increased with 0x8 to use the descriptor at the next higher memory location. The descriptor table is limited to 1 kbytes in size and the pointer will be automatically wrap back to the base address when it reaches the 1 kbytes boundary.
- 25 Enable (EN) - Set to one to activate this descriptor. This means that the descriptor contains valid control values and the memory area pointed to by the packet address field can be used to store a packet.
- 24: 0 Packet length (PACKETLENGTH) - The number of bytes received to this buffer. Only valid after EN has been set to 0 by the GRSPW.

Table 353. RXDMA receive descriptor word 1 (address offset 0x4)

31											0
PACKETADDRESS											

- 31: 0 Packet address (PACKETADDRESS) - The address pointing at the buffer which will be used to store the received packet.

### 33.4.4.6 Setting up the DMA control register

The final step to receive packets is to set the control register in the following steps: The receiver must be enabled by setting the rxen bit in the DMA control register. This can be done anytime and before this bit is set nothing will happen. The rxdescav bit in the DMA control register is then set to indicate that there are new active descriptors. This must always be done after the descriptors have been enabled or the port might not notice the new descriptors. More descriptors can be activated when reception has already started by enabling the descriptors and writing the rxdescav bit. When these bits are set reception will start immediately when data is arriving.

### 33.4.4.7 The effect to the control bits during reception

When the receiver is disabled all packets going to the DMA-channel are discarded if the packet's address does not fall into the range of another DMA channel. If the receiver is enabled and the address falls into the accepted address range, the next state is entered where the rxdescav bit is checked. This bit indicates whether there are active descriptors or not and should be set by the external application using the DMA channel each time descriptors are enabled as mentioned above. If the rxdescav bit is '0' and the nospill bit is '0' the packets will be discarded. If nospill is one the grspw waits until rxdescav is set and the characters are kept in the N-Char fifo during this time. If the fifo becomes full further N-char transmissions are inhibited by stopping the transmission of FCTs.

When rxdescav is set the next descriptor is read and if enabled the packet is received to the buffer. If the read descriptor is not enabled, rxdescav is set to '0' and the packet is spilled depending on the value of nospill.

# LEON3FT Microcontroller

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The receiver can be disabled at any time and will stop packets from being received to this channel. If a packet is currently received when the receiver is disabled the reception will still be finished. The `rxdescav` bit can also be cleared at any time. It will not affect any ongoing receptions but no more descriptors will be read until it is set again. `Rxdescav` is also cleared by the port when it reads a disabled descriptor.

### 33.4.4.8 Status bits

When the reception of a packet is finished the enable bit in the current descriptor is set to zero. When enable is zero, the status bits are also valid and the number of received bytes is indicated in the length field. The DMA control register contains a status bit which is set each time a packet has been received. The port can also be made to generate an interrupt for this event.

The RMAP CRC calculation is always active for all received packets and all bytes except the EOP/EEP are included. The packet is always assumed to be a RMAP packet and the length of the header is determined by checking byte 3 which should be the command field. The calculated CRC value is then checked when the header has been received (according to the calculated number of bytes) and if it is non-zero the HC bit is set indicating a header CRC error.

The CRC value is not set to zero after the header has been received, instead the calculation continues in the same way until the complete packet has been received. Then if the CRC value is non-zero the DC bit is set indicating a data CRC error. This means that the port can indicate a data CRC error even if the data field was correct when the header CRC was incorrect. However, the data should not be used when the header is corrupt and therefore the DC bit is unimportant in this case. When the header is not corrupted the CRC value will always be zero when the calculation continues with the data field and the behaviour will be as if the CRC calculation was restarted

If the received packet is not of RMAP type the header CRC error indication bit cannot be used. It is still possible to use the DC bit if the complete packet is covered by a CRC calculated using the RMAP CRC definition. This is because the port does not restart the calculation after the header has been received but instead calculates a complete CRC over the packet. Thus any packet format with one CRC at the end of the packet calculated according to RMAP standard can be checked using the DC bit.

If the packet is neither of RMAP type nor of the type above with RMAP CRC at the end, then both the HC and DC bits should be ignored.

### 33.4.4.9 Error handling

If an AHB error occurs during reception the current packet is spilled up to and including the next EEP/EOP and then the currently active channel is disabled and the receiver enters the idle state. A bit in the channels control/status register is set to indicate this condition.

### 33.4.4.10 Promiscuous mode

The port supports a promiscuous mode where all received data (excluding EOPs/EEPs) is stored to the first enabled DMA channel regardless of the node address and possible early EOPs/EEPs. The AMBA port DMA RX maximum length register is still checked and packets exceeding this size are truncated.

RMAP commands are still handled by the RMAP hardware target when promiscuous mode is enabled, if the RMAP enable bit in the AMBA port DMA control/status register is set. If the RMAP enable bit is cleared, RMAP commands are stored to a DMA channel instead.

## 33.4.5 Transmitter DMA channels

The transmitter DMA engine handles transmission of data from the DMA channels to the SpaceWire network. Each receive channel has a corresponding transmit channel which means there can be up to 4 transmit channels. It is however only necessary to use a separate transmit channel for each receive

# LEON3FT Microcontroller

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channel if there are also separate entities controlling the transmissions. The use of a single channel with multiple controlling entities would cause them to corrupt each other's transmissions. A single channel is more efficient and should be used when possible.

Multiple transmit channels with pending transmissions are arbitrated in a round-robin fashion.

## 33.4.5.1 Basic functionality of a channel

A transmit DMA channel reads data from the AHB bus and stores them in the transmitter FIFO for transmission on the SpaceWire network. Transmission is based on the same type of descriptors as for the receiver and the descriptor table has the same alignment and size restrictions. When there are new descriptors enabled the port reads them and transfer the amount data indicated.

## 33.4.5.2 Setting up the core for transmission

Four steps need to be performed before transmissions can be done with the port. First the link interface must be enabled and started by writing the appropriate value to the ctrl register. Then the address to the descriptor table needs to be written to the transmitter descriptor table address register and one or more descriptors must also be enabled in the table. Finally, the txen bit in the DMA control register is written with a one which triggers the transmission. These steps will be covered in more detail in the next sections.

## 33.4.5.3 Enabling descriptors

The descriptor table address register works in the same way as the receiver's corresponding register which was covered in section 33.4.4. The maximum size is 1024 bytes as for the receiver but since the descriptor size is 16 bytes the number of descriptors is 64.

To transmit packets one or more descriptors have to be initialized in memory which is done in the following way: The number of bytes to be transmitted and a pointer to the data has to be set. There are two different length and address fields in the transmit descriptors because there are separate pointers for header and data. If a length field is zero the corresponding part of a packet is skipped and if both are zero no packet is sent. The maximum header length is 255 bytes and the maximum data length is 16 Mbyte - 1. When the pointer and length fields have been set the enable bit should be set to enable the descriptor. This must always be done last. The other control bits must also be set before enabling the descriptor.

The transmit descriptors are 16 bytes in size so the maximum number in a single table is 64. The different fields of the descriptor together with the memory offsets are shown in the tables below.

The HC bit should be set if RMAP CRC should be calculated and inserted for the header field and correspondingly the DC bit should be set for the data field. The header CRC will be calculated from the data fetched from the header pointer and the data CRC is generated from data fetched from the data pointer. The CRCs are appended after the corresponding fields. The NON-CRC bytes field is set to the number of bytes in the beginning of the header field that should not be included in the CRC calculation.

The CRCs are sent even if the corresponding length is zero, but when both lengths are zero no packet is sent not even an EOP.

## 33.4.5.4 Starting transmissions

When the descriptors have been initialized, the transmit enable bit in the DMA control register has to be set to tell the port to start transmitting. New descriptors can be activated in the table on the fly (while transmission is active). Each time a set of descriptors is added the transmit enable register bit should be set. This has to be done because each time the core encounters a disabled descriptor this register bit is set to 0.

# LEON3FT Microcontroller

Table 354. TXDMA transmit descriptor word 0 (address offset 0x0)

31		18	17	16	15	14	13	12	11		8	7		0
RESERVED				DC	HC	RE	IE	WR	EN	NONCRCLLEN	HEADERLEN			

- 31: 18      RESERVED
- 17      Append data CRC (DC) - Append CRC calculated according to the RMAP specification after the data sent from the data pointer. The CRC covers all the bytes from this pointer. A null CRC will be sent if the length of the data field is zero.
- 16      Append header CRC (HC) - Append CRC calculated according to the RMAP specification after the data sent from the header pointer. The CRC covers all bytes from this pointer except a number of bytes in the beginning specified by the non-crc bytes field. The CRC will not be sent if the header length field is zero.
- 15      RESERVED
- 14      Interrupt enable (IE) - If set, an interrupt will be generated when the packet has been transmitted and the transmitter interrupt enable bit in the DMA control register is set.
- 13      Wrap (WR) - If set, the descriptor pointer will wrap and the next descriptor read will be the first one in the table (at the base address). Otherwise the pointer is increased with 0x10 to use the descriptor at the next higher memory location.
- 12      Enable (EN) - Enable transmitter descriptor. When all control fields (address, length, wrap and crc) are set, this bit should be set. While the bit is set the descriptor should not be touched since this might corrupt the transmission. The GRSPW clears this bit when the transmission has finished.
- 11: 8      Non-CRC bytes (NONCRCLLEN)- Sets the number of bytes in the beginning of the header which should not be included in the CRC calculation. This is necessary when using path addressing since one or more bytes in the beginning of the packet might be discarded before the packet reaches its destination.
- 7: 0      Header length (HEADERLEN) - Header Length in bytes. If set to zero, the header is skipped.

Table 355. TXDMA transmit descriptor word 1 (address offset 0x4)

31		0
HEADERADDRESS		

- 31: 0      Header address (HEADERADDRESS) - Address from where the packet header is fetched. Does not need to be word aligned.

Table 356. TXDMA transmit descriptor word 2 (address offset 0x8)

31	24	23		0
RESERVED		DATALEN		

- 31: 24      RESERVED
- 23: 0      Data length (DATALEN) - Length of data part of packet. If set to zero, no data will be sent. If both data- and header-lengths are set to zero no packet will be sent.

Table 357. TXDMA transmit descriptor word 3 (address offset 0xC)

31		0
DATAADDRESS		

- 31: 0      Data address (DATAADDRESS) - Address from where data is read. Does not need to be word aligned.

# LEON3FT Microcontroller

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## 33.4.5.5 The transmission process

When the txen bit is set the port starts reading descriptors immediately. The number of bytes indicated are read and transmitted. When a transmission has finished, status will be written to the first field of the descriptor and a packet sent bit is set in the DMA control register. If an interrupt was requested it will also be generated. Then a new descriptor is read and if enabled a new transmission starts, otherwise the transmit enable bit is cleared and nothing will happen until it is enabled again.

## 33.4.5.6 The descriptor table address register

The internal pointer which is used to keep the current position in the descriptor table can be read and written through the APB interface. This pointer is set to zero during reset and is incremented each time a descriptor is used. It wraps automatically when the 1024 bytes limit for the descriptor table is reached or it can be set to wrap earlier by setting a bit in the current descriptor.

The descriptor table register can be updated with a new table anytime when no transmission is active. No transmission is active if the transmit enable bit is zero and the complete table has been sent or if the table is aborted (explained below). If the table is aborted one has to wait until the transmit enable bit is zero before updating the table pointer.

## 33.4.5.7 Error handling

### 33.4.5.7.1 Abort Tx

The DMA control register contains a bit called Abort TX which if set causes the current transmission to be aborted, the packet is truncated and an EEP is inserted. This is only useful if the packet needs to be aborted because of congestion on the SpaceWire network. If the congestion is on the AHB bus this will not help (This should not be a problem since AHB slaves should have a maximum of 16 wait-states). The aborted packet will have its LE bit set in the descriptor. The transmit enable register bit is also cleared and no new transmissions will be done until the transmitter is enabled again.

### 33.4.5.7.2 AHB error

When an AHB error is encountered during transmission the currently active DMA channel is disabled and the transmitter goes to the idle mode. A bit in the DMA channel's control/status register is set to indicate this error condition and, if enabled, an interrupt will also be generated. Further error handling depends on what state the transmitter DMA engine was in when the AHB error occurred. If the descriptor was being read the packet transmission had not been started yet and no more actions need to be taken.

If the AHB error occurs during packet transmission the packet is truncated and an EEP is inserted. Lastly, if it occurs when status is written to the descriptor the packet has been successfully transmitted but the descriptor is not written and will continue to be enabled (this also means that no error bits are set in the descriptor for AHB errors).

The client using the channel has to correct the AHB error condition and enable the channel again. No more AHB transfers are done again from the same unit (receiver or transmitter) which was active during the AHB error until the error state is cleared and the unit is enabled again.

## 33.4.6 RMAP target

The Remote Memory Access Protocol (RMAP) is used to implement access to resources on the AHB bus via the SpaceWire Link. Some common operations are reading and writing to memory, registers and FIFOs. The port has an optional hardware RMAP target. This section describes the target implementation.

# LEON3FT Microcontroller

## 33.4.6.1 Fundamentals of the protocol

RMAP is a protocol which is designed to provide remote access via a SpaceWire network to memory mapped resources on a SpaceWire node. It has been assigned protocol ID 0x01. It provides three operations write, read and read-modify-write. These operations are posted operations which means that a source does not wait for an acknowledge or reply. It also implies that any number of operations can be outstanding at any time and that no timeout mechanism is implemented in the protocol. Time-outs must be implemented in the user application which sends the commands. Data payloads of up to 16 Mb - 1 is supported in the protocol. A destination can be requested to send replies and to verify data before executing an operation. A complete description of the protocol is found in the RMAP standard.

## 33.4.6.2 Implementation

The port includes a target for RMAP commands which processes all incoming packets with protocol ID = 0x01, type field (bit 7 and 6 of the 3rd byte in the packet) equal to 01b and an address falling in the range set by the default address and mask register. When such a packet is detected it is not stored to the DMA channel, instead it is passed to the RMAP receiver.

The target implements all three commands defined in the standard with some restrictions. Support is only provided for 32-bit big-endian systems. This means that the first byte received is the msb in a word. The target will not receive RMAP packets using the extended protocol ID which are always dumped to the DMA channel.

The RMAP receiver processes commands. If they are correct and accepted the operation is performed on the AHB bus and a reply is formatted. If an acknowledge is requested the RMAP transmitter automatically send the reply. RMAP transmissions have priority over DMA channel transmissions.

There is a user accessible destination key register which is compared to destination key field in incoming packets. If there is a mismatch and a reply has been requested the error code in the reply is set to 3. Replies are sent if and only if the ack field is set to '1'.

When a failure occurs during a bus access the error code is set to 1 (General Error). There is predetermined order in which error-codes are set in the case of multiple errors in the core. It is shown in table 358.

Table 358. The order of error detection in case of multiple errors in the AMBA port. The error detected first has number 1.

Detection Order	Error Code	Error
1	12	Invalid destination logical address
2	2	Unused RMAP packet type or command code
3	3	Invalid destination key
4	9	Verify buffer overrun
5	11	RMW data length error
6	10	Authorization failure
7*	1	General Error (AHB errors during non-verified writes)
8	5/7	Early EOP/ EEP (if early)
9	4	Invalid Data CRC
10	1	General Error (AHB errors during verified writes or RMW)
11	7	EEP
12	6	Too Much Data

\*The AHB error is not guaranteed to be detected before Early EOP/EEP or Invalid Data CRC. For very long accesses the AHB error detection might be delayed causing the other two errors to appear first.

Read accesses are performed on the fly, that is they are not stored in a temporary buffer before transmitting. This means that the error code 1 will never be seen in a read reply since the header has already been sent when the data is read. If the AHB error occurs the packet will be truncated and ended with an EEP.

# LEON3FT Microcontroller

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Errors up to and including Invalid Data CRC (number 8) are checked before verified commands. The other errors do not prevent verified operations from being performed.

The details of the support for the different commands are now presented. All defined commands which are received but have an option set which is not supported in this specific implementation will not be executed and a possible reply is sent with error code 10.

### 33.4.6.3 Write commands

The write commands are divided into two subcategories when examining their capabilities: verified writes and non-verified writes. Verified writes have a length restriction of 4 bytes and the address must be aligned to the size. That is 1 byte writes can be done to any address, 2 bytes must be halfword aligned, 3 bytes are not allowed and 4 bytes writes must be word aligned. Since there will always be only one AHB operation performed for each RMAP verified write command the incrementing address bit can be set to any value.

Non-verified writes have no restrictions when the incrementing bit is set to 1. If it is set to 0 the number of bytes must be a multiple of 4 and the address word aligned. There is no guarantee how many words will be written when early EOP/EOP is detected for non-verified writes.

### 33.4.6.4 Read commands

Read commands are performed on the fly when the reply is sent. Thus if an AHB error occurs the packet will be truncated and ended with an EOP. There are no restrictions for incrementing reads but non-incrementing reads have the same alignment restrictions as non-verified writes. Note that the "Authorization failure" error code will be sent in the reply if a violation was detected even if the length field was zero. Also note that no data is sent in the reply if an error was detected i.e. if the status field is non-zero.

### 33.4.6.5 RMW commands

All read-modify-write sizes are supported except 6 which would have caused 3 B being read and written on the bus. The RMW bus accesses have the same restrictions as the verified writes. As in the verified write case, the incrementing bit can be set to any value since only one AHB bus operation will be performed for each RMW command. Cargo too large is detected after the bus accesses so this error will not prevent the operation from being performed. No data is sent in a reply if an error is detected i.e. the status field is non-zero.

### 33.4.6.6 Control

The RMAP target mostly runs in the background without any external intervention, but there are a few control possibilities.

There is an enable bit in the control register of the core which can be used to completely disable the RMAP target. When it is set to '0' no RMAP packets will be handled in hardware, instead they are all stored to the DMA channel.

There is a possibility that RMAP commands will not be performed in the order they arrive. This can happen if a read arrives before one or more writes. Since the target stores replies in a buffer with more than one entry several commands can be processed even if no replies are sent. Data for read replies is read when the reply is sent and thus writes coming after the read might have been performed already if there was congestion in the transmitter. To avoid this the RMAP buffer disable bit can be set to force the target to only use one buffer which prevents this situation.

The last control option for the target is the possibility to set the destination key which is found in a separate register.



# LEON3FT Microcontroller

Table 359. AMBA port hardware RMAP handling of different packet type and command fields.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Command	Action
Reserved	Command / Response	Write / Read	Verify data before write	Acknowledge	Increment Address		
0	0	-	-	-	-	Response	Stored to DMA-channel.
0	1	0	0	0	0	Not used	Does nothing. No reply is sent.
0	1	0	0	0	1	Not used	Does nothing. No reply is sent.
0	1	0	0	1	0	Read single address	Executed normally. Address has to be word aligned and data size a multiple of four. Reply is sent. If alignment restrictions are violated error code is set to 10.
0	1	0	0	1	1	Read incrementing address.	Executed normally. No restrictions. Reply is sent.
0	1	0	1	0	0	Not used	Does nothing. No reply is sent.
0	1	0	1	0	1	Not used	Does nothing. No reply is sent.
0	1	0	1	1	0	Not used	Does nothing. Reply is sent with error code 2.
0	1	0	1	1	1	Read-Modify-Write incrementing address	Executed normally. If length is not one of the allowed rmw values nothing is done and error code is set to 11. If the length was correct, alignment restrictions are checked next. 1 byte can be rmw to any address. 2 bytes must be halfword aligned. 3 bytes are not allowed. 4 bytes must be word aligned. If these restrictions are violated nothing is done and error code is set to 10. If an AHB error occurs error code is set to 1. Reply is sent.
0	1	1	0	0	0	Write, single-address, do not verify before writing, no acknowledge	Executed normally. Address has to be word aligned and data size a multiple of four. If alignment is violated nothing is done. No reply is sent.
0	1	1	0	0	1	Write, incrementing address, do not verify before writing, no acknowledge	Executed normally. No restrictions. No reply is sent.
0	1	1	0	1	0	Write, single-address, do not verify before writing, send acknowledge	Executed normally. Address has to be word aligned and data size a multiple of four. If alignment is violated nothing is done and error code is set to 10. If an AHB error occurs error code is set to 1. Reply is sent.

# LEON3FT Microcontroller

Table 359. AMBA port hardware RMAP handling of different packet type and command fields.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Command	Action
Reserved	Command / Response	Write / Read	Verify data before write	Acknowledge	Increment Address		
0	1	1	0	1	1	Write, incrementing address, do not verify before writing, send acknowledge	Executed normally. No restrictions. If AHB error occurs error code is set to 1. Reply is sent.
0	1	1	1	0	0	Write, single address, verify before writing, no acknowledge	Executed normally. Length must be 4 or less. Otherwise nothing is done. Same alignment restrictions apply as for rmw. No reply is sent.
0	1	1	1	0	1	Write, incrementing address, verify before writing, no acknowledge	Executed normally. Length must be 4 or less. Otherwise nothing is done. Same alignment restrictions apply as for rmw. If they are violated nothing is done. No reply is sent.
0	1	1	1	1	0	Write, single address, verify before writing, send acknowledge	Executed normally. Length must be 4 or less. Otherwise nothing is done and error code is set to 9. Same alignment restrictions apply as for rmw. If they are violated nothing is done and error code is set to 10. If an AHB error occurs error code is set to 1. Reply is sent.
0	1	1	1	1	1	Write, incrementing address, verify before writing, send acknowledge	Executed normally. Length must be 4 or less. Otherwise nothing is done and error code is set to 9. Same alignment restrictions apply as for rmw. If they are violated nothing is done and error code is set to 10. If an AHB error occurs error code is set to 1. Reply is sent.
1	0	-	-	-	-	Unused	Stored to DMA-channel.
1	1	-	-	-	-	Unused	Stored to DMA-channel.

### 33.4.7 AMBA interface

The AMBA interface consists of an APB interface, an AHB master interface and DMA FIFOs. The APB interface provides access to the user registers. The DMA engines have 32-bit wide FIFOs to the AHB master interface which are used when reading and writing to the bus.

The transmitter DMA engine reads data from the bus in bursts which are half the FIFO size in length. A burst is always started when the FIFO is half-empty or if it can hold the last data for the packet. The burst containing the last data might have shorter length if the packet is not an even number of bursts in size.

The receiver DMA works in the same way except that it checks if the FIFO is half-full and then performs a burst write to the bus which is half the fifo size in length. The last burst might be shorter. Byte accesses are used for non word-aligned buffers and/or packet lengths that are not a multiple of four

# LEON3FT Microcontroller

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bytes. There might be 1 to 3 single byte writes when writing the beginning and end of the received packets.

### 33.4.7.1 APB slave interface

As mentioned above, the APB interface provides access to the user registers which are 32-bits in width. The accesses to this interface are required to be aligned word accesses. The result is undefined if this restriction is violated.

### 33.4.7.2 AHB master interface

The port contains a single master interface which is used by both the transmitter and receiver DMA engines. The arbitration algorithm between the channels is done so that if the current owner requests the interface again it will always acquire it. This will not lead to starvation problems since the DMA engines always deassert their requests between accesses.

### 33.4.8 Registers

The port is programmed through registers mapped into APB address space. The addresses in the table below are offsets from each port's base address. The actual AMBA AHB address used to access the port is determined as follows: The AMBA ports' registers are accessed through an APB interface which resides on the APB bus. The APB bus is connected to the AHB bus using an APB controller whose AHB address determines the first base address for the AMBA ports.

# LEON3FT Microcontroller

Table 360. AMBA port registers

APB address offset**	Register name	Acronym
0x00	AMBA port Control	RTR.AMBACTRL
0x40	AMBA port Status	RTR.AMBASTS
0x08	AMBA port Default address	RTR.AMBADEFADDR
0x0C	RESERVED	
0x10	AMBA port Destination key	RTR.AMBADKEY
0x14	AMBA port Time-code	RTR.AMBATC
0x18	RESERVED	
0x20, 0x40, 0x60, 0x80	AMBA port DMA control/status, channels 1 - 4 *	RTR.AMBADMACTRL
0x24, 0x44, 0x64, 0x84	AMBA port DMA RX maximum length, channels 1 - 4 *	RTR.AMBADMAMAXLEN
0x28, 0x48, 0x68, 0x88	AMBA port DMA transmit descriptor table address, channels 1 - 4 *	RTR.AMBADMATXDESC
0x2C, 0x4C, 0x6C, 0x8C	AMBA port DMA receive descriptor table address, channels 1 - 4 *	RTR.AMBADMARXDESC
0x30, 0x50, 0x70, 0x90	AMBA port DMA address, channels 1 - 4 *	RTR.AMBADMAADDR
0x34, 0x54, 0x74, 0x94	RESERVED	
0x38, 0x58, 0x78, 0x98	RESERVED	
0x3C, 0x5C, 0x7C, 0x9C	RESERVED	
0xA0	AMBA port Distributed interrupt control	RTR.AMBAINCTRL
0xA4	AMBA port Interrupt receive	RTR.AMBAINTRX
0xA8	AMBA port Interrupt acknowledgement / extended interrupt receive	RTR.AMBAACKRX
0xAC	AMBA port Interrupt timeout, interrupt 0-31	RTR.AMBAINTTO0
0xB0	AMBA port Interrupt timeout, interrupt 32-63	RTR.AMBAINTTO1
0xB4	AMBA port Interrupt mask, interrupt 0-31	RTR.AMBAINTMSK0
0xB8	AMBA port Interrupt mask, interrupt 32-63	RTR.AMBAINTMSK1
0xBC - 0xFF	RESERVED	

\* One identical register per DMA channel. Register is only described once

# LEON3FT Microcontroller

Table 361. 0x00 - RTR.AMBACTRL - AMBA port Control

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RA	RX	RC	NCH	RES	DI	ME	RESERVED				RD	RE	RESERVED				TQ	R	RS	PM	TI	IE	RESERVED								
1	1	1	0x3	0x0	1	0	0x00				0	1	0x00				0	0	0	0	0	0	0	0x0							
r	r	r	r	r	r	r	r				rw	rw	r				rw	r	rw	rw	rw	rw	rw	r							

- 31 RMAP available (RA) - Constant value of 1, indicating that the RMAP target is implemented.
- 30 RX unaligned access (RX) - Constant value of 1, indicating that unaligned writes are available for the receiver.
- 29 RMAP CRC available (RC) - Constant value of 1, indicating that RMAP CRC is enabled.
- 28: 27 Number of DMA channels (NCH) - The number of available DMA channels minus one. Constant value of 0x3.
- 26: 25 RESERVED
- 24 Distributed interrupt support (DI) - Constant value of 1, indicating that distributed interrupts are supported.
- 23 Memory error truncation enable (ME) - If set to 1, a packet being transmitted will be truncated with an EEP if an error occur while reading from the AMBA port's TX FIFO.
- 22: 18 RESERVED
- 17 RMAP buffer disable (RD) - If set only one RMAP buffer is used. This ensures that all RMAP commands will be executed consecutively.
- 16 RMAP Enable (RE) - Enable RMAP target.
- 15: 9 RESERVED
- 8 Tick-out IRQ (TQ) - Generate interrupt when a valid time-code is received if the time-code also matches the time-code filter specified by the RTR.AMBATIME.TCMSK and RTR.AMBATIME.TCVAl fields.
- 7 Time-code tick-out enable (TO) - If set to 1, the internal tickout signal is set when a valid time-code is received. if the time-code also matches the time-code filter specified by the RTR.AMBATIME.TCMSK and RTR.AMBATIME.TCVAl fields.
- 6 Reset (RS) - Make complete reset of the SpaceWire node. Self clearing.
- 5 Promiscuous Mode (PM) - Enable Promiscuous mode.
- 4 Tick In (TI) - The host can generate a tick by writing a one to this field. This will increment the timer counter and the new value is transmitted after the current character is transferred. A tick can also be generated by asserting the tick\_in signal.
- 3 Interrupt Enable (IE) - If set, an interrupt is generated when bit 8 is set and its corresponding event occurs.
- 2: 0 RESERVED

# LEON3FT Microcontroller

Table 362. 0x04 - RTR.AMBASTS - AMBA port Status

31	30	28	27	26	25	24	23	13	12	11	9	8	7	0
R	NIRQ	NRXD	NTXD	RESERVED				ME	RESERVED	EE	IA	RESERVED		TO
0	0x6	0	0	0x000				0	0x0	0	0	0x00		0
r	r	r	r	r				wc	r	wc	wc	r		wc

- 31: RESERVED
- 30: 28 Number of interrupts (NIRQ) - Shows the number of support distributed interrupt, according to the formula  $2^{NIRQ}$ . Constant value of 0x6 = 64 supported interrupts.
- 27: 26 Number of receive descriptors (NRXD) - Shows the size of the DMA receive descriptor table. Constant value of 0, indicating 128 descriptors.
- 25: 24 Number of transmit descriptors (NTXD) - Shows the size of the DMA transmit descriptor table. Constant value of 0, indicating 64 descriptors.
- 23: 13 RESERVED
- 12 Memory error packet truncation (ME) - This bit is set to one when a transmitted packet is truncated with an EEP due to a memory error in the AMBA ports' TX FIFO.
- 11: 9 RESERVED
- 8 Early EOP/EEP (EE) - Set to one when a packet is received with an EOP after the first byte for a non-RMAP packet and after the second byte for an RMAP packet.
- 7 Invalid Address (IA) - Set to one when a packet is received with an invalid destination address field, i.e it does not match the nodeaddr register.
- 6: 1 RESERVED
- 0 Tick Out (TO) - A new time count value was received and is stored in the time counter field.

Table 363. 0x08 - RTR.AMBADEFADDR - AMBA port Default address

31	16	15	8	7	0
RESERVED			DEFMASK	DEFADDR	
0x0000			0x00	0xFE	
r			rw	rw	

- 31: 8 RESERVED
- 15: 8 Default mask (DEFMASK) - Default mask used for node identification on the SpaceWire network. This field is used for masking the address before comparison. Both the received address and the DEFADDR field are anded with the inverse of DEFMASK before the address check.
- 7: 0 Default address (DEFADDR) - Default address used for node identification on the SpaceWire network. Reset value: 254.

Table 364. 0x10 - RTR.AMBADKEY - AMBA port Destination key

31	8	7	0
RESERVED		DESTKEY	
NA		0x00	
r		rw	

- 31: 8 RESERVED
- 7: 0 Destination key (DESTKEY) - RMAP destination key.

# LEON3FT Microcontroller

Table 365. 0x14 - RTR.AMBATC - AMBA port Time-code

31	24	23	16	15	8	7	6	5	0
TCMSK		TCVAL			RESERVED		TCTRL	TIMECNT	
0x00		0x00			0x00		0x0	0x00	
rw		rw			r		rw	rw	

- 31: 24 Time-code filter mask (TCMSK) - If a bit in this field is set to 1 then the corresponding bit in the RTR.AMBA-TIME.TCVAL field must match the value of the same bit in a received time-code in order for that time-code to generate an AMBA IRQ or a pulse on the internal tickout signals connected to the general purpose timers.
- 23: 16 Time-code filter value (TCVAL) - For each bit set to 1 in the RTR.AMBATIME.TCMSK, the corresponding bit in this field must match the value of the same bit of a received time-code in order to that time-code to generate and AMBA IRQ, or a pulse on the internal tickout signals connected to the general purpose timers.
- 15: 8 RESERVED
- 7: 6 Time control flags (TCTRL) - The current value of the time control flags. Sent with time-code resulting from a tick-in. Received control flags are also stored in this register.
- 5: 0 Time counter (TIMECNT) - The current value of the system time counter. It is incremented for each tick-in and the incremented value is transmitted. The register can also be written directly but the written value will not be transmitted. Received time-counter values are also stored in this register

# LEON3FT Microcontroller

Table 366. 0x20,0x40,0x60,0x80 - RTR.AMBADMACTRL - AMBA port DMA control/status

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
INTNUM		RES	EP	TR	IE	IT	RP	TP	RES	SP	SA	EN	NS	RD	RX	AT	RA	TA	PR	PS	AI	RI	TI	RE	TE						
0x00		0x0	0	0	0	0	0	0	0x0	0	0	0	0	0	0	0	0	0	0	0	0	NR	NR	NR	0	0					
rw		r	wc	wc	rw	rw	wc	wc	r	rw	rw	rw	rw	rw	r	rw	wc	wc	wc	wc	rw	rw	rw	rw	rw						

- 31: 26 Interrupt number (INTNUM) - The interrupt number used for this DMA channel when sending a distributed interrupt code that was generated due to any of the events maskable by the RTR.AMBADMACTRL.IE and RTR.AMBADMACTRL.IT bits. The value in this field should be in the range 0 to 31.
- 25: 24 RESERVED
- 23 EEP termination (EP) - Set to 1 when a received packet for the corresponding DMA channel ended with an Error End of Packet (EEP) character.
- 22 Truncated (TR) - Set to 1 when a received packet for the corresponding DMA channel is truncated due to a maximum length violation.
- 21 Interrupt transmit enable on EEP (IE) - When set to 1, the distributed interrupt code specified in the RTR.AMBADMACTRL.INTNUM field is generated when a received packet on this DMA channel ended with an Error End of Packet (EEP) character.
- 20 Interrupt-code transmit enable on truncation (IT) - When set to 1, the distributed interrupt code specified in the RTR.AMBADMACTRL.INTNUM field is generated when a received packet on this DMA channel is truncated due to a maximum length violation.
- 19 Receive packet IRQ (RP) - This bit is set to 1 when an AMBA interrupt was generated due to the fact that a packet was received for the corresponding DMA channel.
- 18 Transmit packet IRQ (TP) - This bit is set to 1 when an AMBA interrupt was generated due to the fact that a packet was transmitted for the corresponding DMA channel.
- 17: 16 RESERVED
- 15 Strip pid (SP) - Remove the pid byte (second byte) of each packet. The address byte (first byte) will also be removed when this bit is set independent of the SA bit.
- 14 Strip addr (SA) - Remove the addr byte (first byte) of each packet.
- 13 Enable addr (EN) - Enable separate node address for this channel.
- 12 No spill (NS) - If cleared, packets will be discarded when a packet is arriving and there are no active descriptors. If set, the GRSPW will wait for a descriptor to be activated.
- 11 Rx descriptors available (RD) - Set to one, to indicate to the GRSPW that there are enabled descriptors in the descriptor table. Cleared by the GRSPW when it encounters a disabled descriptor:
- 10 RX active (RX) - Is set to '1' if a reception to the DMA channel is currently active otherwise it is '0'.
- 9 Abort TX (AT) - Set to one to abort the currently transmitting packet and disable transmissions. If no transmission is active the only effect is to disable transmissions. Self clearing.
- 8 RX AHB error (RA) - An error response was detected on the AHB bus while this receive DMA channel was accessing the bus. The AHB error interrupt (AI) field must be set to '1' for the RA field to be set.
- 7 TX AHB error (TA) - An error response was detected on the AHB bus while this transmit DMA channel was accessing the bus.
- 6 Packet received (PR) - This bit is set each time a packet has been received. never cleared by the SW-node.
- 5 Packet sent (PS) - This bit is set each time a packet has been sent. Never cleared by the SW-node.
- 4 AHB error interrupt (AI) - If set, an interrupt will be generated each time an AHB error occurs when this DMA channel is accessing the bus.
- 3 Receive interrupt (RI) - If set, an interrupt will be generated each time a packet has been received. This happens both if the packet is terminated by an EEP or EOP.
- 2 Transmit interrupt (TI) - If set, an interrupt will be generated each time a packet is transmitted. The interrupt is generated regardless of whether the transmission was successful or not.
- 1 Receiver enable (RE) - Set to one when packets are allowed to be received to this channel.
- 0 Transmitter enable (TE) - Write a one to this bit each time new descriptors are activated in the table. Writing a one will cause the SW-node to read a new descriptor and try to transmit the packet it points to. This bit is automatically cleared when the SW-node encounters a descriptor which is disabled.



# LEON3FT Microcontroller

Table 367. 0x24,0x44,0x64,0x84 - RTR.AMBADMAMAXLEN - AMBA port DMA RX maximum length

31	25 24	2 1 0
RESERVED	RXMAXLEN	RES
0x00	N/R	0x0
r	rw	r

- 31: 25      RESERVED
- 24: 2      RX maximum length (RXMAXLEN) - Receiver packet maximum length in 32-bit words.
- 1: 0      RESERVED

Table 368. 0x28,0x48,0x68,0x88 - RTR.AMBADMATXDESC - AMBA port DMA transmit descriptor table address

31	10 9	4 3	0
DESCBASEADDR	DESCSEL	RESERVED	
N/R	0x00	0x0	
rw	rw	r	

- 31: 10      Descriptor table base address (DESCBASEADDR) - Sets the base address of the descriptor table.
- 9: 4      Descriptor selector (DESCSEL) - Offset into the descriptor table. Shows which descriptor is currently used by the GRSPW. For each new descriptor read, the selector will increase with 16 and eventually wrap to zero again.
- 3: 0      RESERVED

Table 369. 0x2C,0x4C,0x6C,0x8C - RTR.AMBADMARXDESC - AMBA port DMA receive descriptor table address

31	10 9	3 2	0
DESCBASEADDR	DESCSEL	RESERVED	
N/R	0x00	0x0	
rw	rw	r	

- 31: 10      Descriptor table base address (DESCBASEADDR) - Sets the base address of the descriptor table. Not reset.
- 9: 3      Descriptor selector (DESCSEL) - Offset into the descriptor table. Shows which descriptor is currently used by the GRSPW. For each new descriptor read, the selector will increase with 8 and eventually wrap to zero again. Reset value: 0.
- 2: 0      RESERVED

Table 370. 0x30,0x50,0x70,0x90 - RTR.AMBADMAADDR - AMBA port DMA address

31	16 15	8 7	0
RESERVED	MASK	ADDR	
0x0000	N/R	N/R	
r	rw	rw	

- 31: 8      RESERVED
- 15: 8      Mask (MASK) - Mask used for node identification on the SpaceWire network. This field is used for masking the address before comparison. Both the received address and the ADDR field are anded with the inverse of MASK before the address check.
- 7: 0      Address (ADDR) - Address used for node identification on the SpaceWire network for the corresponding dma channel when the EN bit in the DMA control register is set.

# LEON3FT Microcontroller

Table 371. 0xA0 - RTR.AMBAINCTRL - AMBA port Distributed interrupt control

31	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	8	7	6	5	0
INTNUM	R	EE	IA	RES	TQ	AQ	IQ	RES	AA	AT	IT	RESERVED				ID	II	TXINT		
0x00	0	0	0	0x0	0	0	0	0x0	0	1	1	0x00				0	0	0x00		
rw	r	rw	rw	r	rw	rw	rw	r	rw	rw	rw	r				wc	rw*	rw		

- 31: 26 Interrupt number (INTNUM) - The interrupt-number used when sending an interrupt code that was generated due to any of the events maskable by the RTR.AMBAINCTRL.ER and RTR.AMBAINCTRL.IA bits. Note that when RTR.RTRCFG.EE = 0 (interrupt with acknowledgement mode), this field must no be set to a value greater than 31.
- 25 RESERVED
- 24 Interrupt transmit on early EOP/EEP (EE) - If set to 1, a distributed interrupt code with the interrupt number specified in the RTR.AMBAINCTRL.INTNUM field is sent each time an event occurs such that the STS.EE bit is set to 1 (even if the bit was already set when the event occurred).
- 23 Interrupt transmit on invalid address (IA) - If set to 1, a distributed interrupt code with the interrupt number specified in the RTR.AMBAINCTRL.INTNUM field is sent each time an event occurs such that the STS.IA bit is set to 1 (even if the bit was already set when the event occurred).
- 22: 21 RESERVED
- 20 Interrupt timeout IRQ enable (TQ) - When set to 1, an AMBA interrupt is generated when a bit in the RTR.AMBAINCTO0 or RTR.AMBAINCTO1 registers is set. Note that the RTR.AMBAINCTRL.IE bit also must be set for this bit to have any effect.
- 19 Interrupt acknowledgment / extended interrupt receive IRQ enable (AQ) - When set to 1, an AMBA interrupt is generated when an interrupt acknowledgment code or extended interrupt code is received such that a bit in the RTR.AMBAACKRX register is set to 1 (even if the bit was already set when the code was received).
- 18 Interrupt-code receive IRQ enable (IQ) - When set to 1, an AMBA interrupt is generated when an interrupt code is received such that a bit in the RTR.AMBAINTRX register is set to 1 (even if the bit was already set when the code was received).
- 17: 16 RESERVED
- 15 Handle all interrupt acknowledgment codes (AA) - Is set to 0, only those received interrupt acknowledgment codes that match an interrupt code sent by software are handled. If set to 1, all received interrupt acknowledgment codes are handled.
- 14 Interrupt acknowledgment / extended interrupt tickout enable (AT) - When set to 1, the internal tickout signal from this AMBA port is set when an interrupt acknowledgment code or extended interrupt code is received such that a bit in the RTR.AMBAACKRX register is set to 1 (even if the bit was already set when the code was received).
- 13 Interrupt tickout enable (IT) - When set to 1, the internal tickout signal from this AMBA port is set when an interrupt code is received such that a bit in the RTR.AMBAINTRX register is set to 1 (even if the bit was already set when the code was received).
- 12: 8 RESERVED
- 7 Interrupt discarded (ID) - This bit is set to 1 when a distributed interrupt code that software tried to send by writing the RTR.AMBAINCTRL.II bit was discarded by the routers switch matrix. There is a maximum of ten clock cycle delay between the RTR.AMBAINCTRL.II bit being written and this bit being set.
- 6 Interrupt-code tick-in (II) - When this field is written to 1 the distributed interrupt code specified by the RTR.AMBAINCTRL.TXINT field will be sent out from the AMBA port to the routers switch matrix. This bit is automatically cleared and always reads '0'. Writing a '0' has no effect.
- 5: 0 Transmit distributed interrupt code (TXINT) - The distributed interrupt code that will be sent when the register RTR.AMBAINCTRL.II is written with 1.

Table 372. 0xA4 - RTR.AMBAINTRX - AMBA port Interrupt receive

31	RXIRQ	0
	0x00000000	
	wc	

31: 0 Received interrupt code (RXIRQ) - Each bit corresponds to the interrupt number with the same number as the bit index. A position is set to 1 when an interrupt code is received for which the corresponding bit in the RTR.AMBAINTRX register is set to 1.

Table 373. 0xA8 - RTR.AMBAACKRX - AMBA port Interrupt acknowledgment / extended interrupt receive

31	RXACK	0
	0x00000000	
	wc	

31: 0 Received interrupt acknowledgment code / extended interrupt code (RXACK) - When operating in extended interrupt mode (RTR.RTRCFG.EE = 1) then each bit corresponds to the interrupt number with the same number as the bit index plus 32, i.e bit 0 corresponds to interrupt number 32, bit 1 to interrupt number 33 etc. This bit gets set to 1 when an extended interrupt code is received for which the corresponding bit in the RTR.AMBAINTRX register is set to 1.

When operating in interrupt with acknowledgment mode (RTR.RTRCFG.EE = 0) then each bit corresponds to the interrupt number with the same number as the bit index. This bit gets set to 1 an interrupt acknowledgment code is received for which the corresponding bit in the RTR.AMBAINTRX register is set, and either if RTR.AMBAINTRX.AA is set to 1 or for which the matching interrupt code was sent by software.

Table 374. 0xAC - RTR.AMBAINTRX0 - AMBA port Interrupt timeout, interrupt 0-31

31	INTTO	0
	0x00000000	
	wc	

31: 0 Interrupt code timeout (INTTO) - Each bit corresponds to the interrupt number with the same number as the bit index. This bit is set to 1 when an interrupt code that was sent by software doesn't receive an interrupt acknowledgment code for the duration of a timeout period (specified in the RTR.ISRTIMER register), and if the corresponding bit in the RTR.AMBAINTRX0 register is set.

Table 375. 0xAC - RTR.AMBAINTRX1 - AMBA port Interrupt timeout, interrupt 32-63

31	INTTO	0
	0x00000000	
	wc	

31: 0 Extended interrupt code timeout (INTTO) - Each bit corresponds to the interrupt number with the same number as the bit index plus 32, i.e bit 0 corresponds to interrupt number 32, bit 1 to interrupt number 33 etc.. This bit is set to 1 when an extended interrupt code that was sent by software time out, i.e after the duration of a timeout period (specified in the RTR.ISRTIMER register), and if the corresponding bit in the RTR.AMBAINTRX1 register is set.

# LEON3FT Microcontroller

Table 376. 0xB0 - RTR.AMBAINTRMSK0 - AMBA port Interrupt mask, interrupt 0-31

31	0
MASK	
0x00000000	
rw	

31: 0 Interrupt mask (MASK) - Each bit corresponds to the interrupt number with the same value as the bit index. If a bit is set to 0, all received interrupt codes and interrupt acknowledgment codes with the interrupt identifier corresponding to that bit is ignored. If a bit is set to 1, then the matching distributed interrupt code is handled.

Table 377. 0xB0 - RTR.AMBAINTRMSK1 - AMBA port Interrupt mask, interrupt 32-63

31	0
MASK	
0x00000000	
rw	

31: 0 Interrupt mask (MASK) - Each bit corresponds to the interrupt number with the same value as the bit index plus 32, i.e bit 0 corresponds to interrupt number 32, bit 1 to interrupt number 33 etc. If a bit is set to 0, all received extended interrupt codes with the interrupt identifier corresponding to that bit is ignored. If a bit is set to 1, then the matching distributed interrupt code is handled.

## 33.5 Configuration port

The configuration port has port number 0. It consists of an RMAP target, AMBA AHB slave interface, SpaceWire Plug-and-Play interface, and a set of configuration and status registers.

### 33.5.1 RMAP target

#### 33.5.1.1 Overview

The configuration port's RMAP target implements the RMAP protocol, as defined in the RMAP standard [RMAP]. Verified writes and reads up to 128 B, and read-modify-writes of 4 B (8 B if the mask field is included in the count) are supported. Replies from the configuration port are always sent to the port they arrived on, regardless of the values of the RMAP command's Initiator Logical Address field, and Reply Address field. The address space of the configuration port is specified in section 33.6.

Additional requirements on the RMAP commands imposed by the configuration port's RMAP target are:

- The Target Logical Address field must be 0xFE.
- The Address fields must contain a 4 B aligned address.
- The Extended Address field must be 0x00.
- Key field must be 0x00.
- For write and read commands the Data Length fields must contain a value that is a multiple of 4, ranging from 0 to 128 B.
- For read-modify-write commands the Data Length fields must contain a value of 0 or 8.
- For write commands the Verify Data Before Write bit in the Instruction field must be set to 1.

# LEON3FT Microcontroller

How the RMAP target handles commands that does not meet the above requirement is detailed in sections 33.5.1.2 and 33.5.1.4.

When an RMAP write command larger than 4 bytes is processed (i.e. more than one register written by the same command), the registers will not change value simultaneously. The command is buffered locally, since only verified write commands are allowed, and then read out from the buffer and written to the registers, with one CLK cycle delay between each register write. This needs to be considered when for example updating large parts of the routing table. Data traffic that arrives while the RMAP command is being processed may or may not be routed according to the new values depending on the address of the packet and how much of the RMAP command that has been processed. Note that the RMAP target is blocked while the RMAP write command is being processed, which means that data returned in an RMAP read command is always either the value before or after the complete RMAP write, never in between.

## 33.5.1.2 RMAP command support

Table 378 lists all possible RMAP commands and shows how the configuration port's RMAP target handles them. An RMAP command will always have bits 7:6 of the command's Instruction field set to "01", and those bits are therefore left out of the table. Bits 1:0 of the command's Instruction field determines the length of the command's Reply Address Field, and does not affect the action taken, so they have been left out of the table as well. The action taken assumes that no errors were detected in the RMAP packet. For handling of RMAP packet error, see section 33.5.1.4.

Table 378. RMAP command decoding and handling.

Bit 5	Bit 4	Bit 3	Bit 2	Function	Action taken
Write / Read	Verify Data Before Write	Reply	Increment Addr		
0	0	0	0	Invalid	No operation performed. Error code 0x02 is saved in the RTR.PCTRLCFG.EC field. No reply is sent.
0	0	0	1	Invalid	No operation performed. Error code 0x02 is saved in the RTR.PCTRLCFG.EC field. No reply is sent.
0	0	1	0	Read single address	Read operation performed, if the requirements in section 33.5.1.1 are met.
0	0	1	1	Read incrementing address	Read operation performed, if the requirements in section 33.5.1.1 are met.
0	1	0	0	Invalid	No operation performed. Error code 0x02 is saved in the RTR.PCTRLCFG.EC field. No reply is sent.
0	1	0	1	Invalid	No operation performed. Error code 0x02 is saved in the RTR.PCTRLCFG.EC field. No reply is sent.
0	1	1	0	Invalid	No operation performed. Reply is sent with error code 0x02. Error code is also saved in the RTR.PCTRLCFG.EC field.
0	1	1	1	Read-modify-write incrementing address	Read-modify-write operation performed if the requirements in section 33.5.1.1 are met.
1	0	0	0	Write, single address, don't verify before writing, no reply	No operation performed. Error code 0x0A is saved in the RTR.PCTRLCFG.EC field. No reply sent.

# LEON3FT Microcontroller

Table 378. RMAP command decoding and handling.

Bit 5	Bit 4	Bit 3	Bit 2	Function	Action taken
Write / Read	Verify Data Before Write	Reply	Increment Addr		
1	0	0	1	Write, incrementing address, don't verify before writing, no reply	No operation performed. Error code 0x0A is saved in the RTR.PCTRLCFG.EC field. No reply sent.
1	0	1	0	Write, single address, don't verify before write, send reply	No operation performed. Reply is sent with error code 0x0A. Error code is also saved in the RTR.PCTRLCFG.EC field.
1	0	1	1	Write, incrementing address, don't verify before write, send reply	No operation performed. Reply is sent with error code 0x0A. Error code is also saved in the RTR.PCTRLCFG.EC field.
1	1	0	0	Write, single address, verify before writing, no reply	Write operation performed if the requirements in section 33.5.1.1 are met.
1	1	0	1	Write, incrementing address, verify before writing, no reply	Write operation performed if the requirements in section 33.5.1.1 are met.
1	1	1	0	Write, single address, verify before writing, send reply	Write operation performed if the requirements in section 33.5.1.1 are met.
1	1	1	1	Write, incrementing address, verify before writing, send reply	Write operation performed if the requirements in section 33.5.1.1 are met.

### 33.5.1.3 Access control

After reset / power-up the configuration port's address space can be accessed from all the ports. Configuration port accesses can be individually disabled per port by clearing the corresponding RTR.PCTRL.CE bit. Write commands, and read-modify-write commands to the configuration area can be globally disabled by writing a 0 to the RTR.CFGWE.WE bit.

There is also a CFGLOCK pin which can be used to disable configuration accesses from all ports except port 1 and 2. This signal overrides the setting of the RTR.PCTRL.CE for all ports, enabling configuration port accesses for port 1 and 2, and disabling them for all other ports. The RTR.CFGWE register still affects ports 1 and 2 in this case.

When a correct RMAP command is received but not allowed due to one or more of the access control features being enabled, a reply with Status field set to 0x0A (Authorization failure) is sent (if requested), and the RTR.PSTSCFG.EC field is updated to reflect the error. If a reply is not requested, the RTR.PSTSCFG.EC field is still set. In both cases, the operation is not performed.

# LEON3FT Microcontroller

## 33.5.1.4 RMAP Error handling

Table 379 shows the order in which errors in an RMAP command are detected. As soon as an error is detected, the command is discarded. If a reply should be sent, to a command that included an error, the reply is sent as soon as possible after the error is detected. This means that the reply might be sent out before the complete incoming RMAP command has been received. Note that since the complete RMAP command is buffered before it is executed, a command that contains an error is never executed.

Table 379. RMAP target error detection order

Detection Order	Error type	RMAP error code	Action taken
1	Wrong Protocol Identifier	N/A	The RTR.PSTSCFG.PT bit is set in order to indicate that the error occurred. No reply is sent.
2	EOP / EEP before completed header	N/A	The RTR.PSTSCFG.EO / RTR.PSTSCFG.EE bit is set in order to indicate that the error occurred. No reply is sent.
3	Header CRC error	N/A	The RTR.PSTSCFG.HC bit is set in order to indicate that the error occurred. No reply is sent.
4	Unused RMAP packet type	N/A	If the packet type (bit 7:6 of the packet's Instruction field) is "10" or "11" then the bit RTR.PSTSCFG.PT is set. For the value "00" (indicating a reply), no bit in RTR.PSTSCFG is set, since the RMAP standard [RMAP] does not specify that such an event should be recorded.
5	EEP immediately after header	N/A	The RTR.PSTSCFG.EE bit is set in order to indicate that the error occurred. No reply is sent.
6	Unused RMAP command code	0x02	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
7	Invalid Target Logical Address	0x0C	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
8	Invalid Key	0x03	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
9	Verify buffer overrun	0x09	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
10	RMW data length error	0x0B	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
11	RMAP command not implemented or not authorized.	0x0A	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
12	Early EOP / early EEP (not immediately after header)	0x05 / 0x07	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
13	Invalid Data CRC	0x04	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
14	EEP	0x07	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.
15	Too much data	0x06	RMAP error code is saved in the RTR.PCTRLCFG.EC field. Reply is sent if the Reply bit in the command's Instruction field was set to 1.

Most of the errors listed in table 379 are errors that only occur in one specific way, and they are also explained in the RMAP standard [RMAP]. Authorization failure (error code 0x0A) is however an exception. All the cases that lead to an authorization failure are listed below:

- A read command's Data Length field exceed 128 B.

# LEON3FT Microcontroller

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- A command's (read, write, or read-modify-write) Address field does not contain a 4 B aligned address.
- The access control features described in section 33.5.1.3 prevented the port from accessing the RMAP target.
- The Address field of a command (read, write, or read-modify-write) contains an address that is outside of the configuration port's memory space.
- The Address field of the command (read, write, or read-modify-write) combined with the Length field would generate an access outside of the configuration port's memory space.
- The Length field of a command (read, write, or read-modify write) is not a multiple of 4.
- A non-verified write command was received.

## 33.5.2 AMBA AHB slave interface

The configuration port provides an AMBA AHB slave interface, which makes the whole configuration port's address space accessible from the AHB bus. The address offsets are the same as when accessing through RMAP but the base address is different.

The routing table is shared between the ports, RMAP target and AHB slave, so accesses from the AHB slave might be stalled because of accesses from the other sources. The priority order when accessing the routing table, starting from the highest, is: router ports, AHB slave, RMAP target. Note that since the AHB slave has higher priority than the RMAP target, it is possible to read and write to the configuration port's registers in the middle of an RMAP write command. This needs to be considered in order to avoid a mismatch between the expected written value and actual written value.

None of the access control mechanisms mentioned in section 33.5.1.3 have any effect on the AHB slave interface.



# LEON3FT Microcontroller

## 33.6 Registers

The configuration port's registers listed in this section can be accessed either through the RMAP target, or the AMBA AHB slave interface. The RMAP addresses specified in table 380. The AHB addresses are determined by adding the RAMP addresses table 380 to the AHB base address for the controller in section 2.10. Registers that exist in several identical copies, corresponding to different addresses or ports, for example the RTR.RTPMAP registers, are only described once.

Only 32-bit single-accesses to the registers through AHB are supported.

Table 380. GRSPWROUTER registers

RMAP address	Register name	Acronym
0x00000000	RESERVED *	
0x00000004 - 0x0000000C	Routing table port mapping, physical addresses 1-3	RTR.RTPMAP
0x00000080 - 0x000003FC	Routing table port mapping, logical addresses 32-255	RTR.RTPMAP
0x00000400	RESERVED *	
0x00000404 - 0x0000040C	Routing table address control, physical addresses 1-3	RTR.RTACTRL
0x00000480 - 0x000007FC	Routing table address control, logical addresses 32-255	RTR.RTACTRL
0x00000800	Port control, port 0 (configuration port)	RTR.PCTRLCFG
0x00000804 - 0x0000080C	Port control, port 1-3	RTR.PCTRL
0x00000880	Port status, port 0 (configuration port)	RTR.PSTSCFG
0x00000884 - 0x0000088C	Port status, ports 1-3	RTR.PSTS
0x00000900 - 0x0000090C	Port timer reload, ports 0-3	RTR.PTIMER
0x00000980	Port control 2, ports 0 (configuration port)	RTR.PCTRL2CFG
0x00000984 - 0x0000098C	Port control 2, ports 1-3	RTR.PCTRL2
0x00000A00	Router configuration / status	RTR.RTRCFG
0x00000A04	Time-code	RTR.TC
0x00000A08	Version / instance ID	RTR.VER
0x00000A0C	Initialization divisor	RTR.IDIV
0x00000A10	Configuration write enable	RTR.CFGWE
0x00000A14	Timer prescaler reload	RTR.PRESCALER
0x00000A18	Interrupt mask	RTR.IMASK
0x00000A1C	Interrupt port mask	RTR.IPMASK
0x00000A20	Port interrupt pending	RTR.PIP
0x00000A24	Interrupt code generation	RTR.ICODEGEN
0x00000A28	Interrupt code distribution ISR, interrupt 0-31	RTR.ISR0
0x00000A2C	Interrupt code distribution ISR, interrupt 32-63	RTR.ISR1
0x00000A30	Interrupt code distribution ISR timer reload	RTR.ISRTIMER
0x00000A34	Interrupt code distribution ACK-to-INT timer reload	RTR.AITIMER
0x00000A38	Interrupt code distribution ISR change timer reload	RTR.ISRCTIMER
0x00000A3C	RESERVED	
0x00000A40	SpaceWire link running status	RTR.LRUNSTS

# LEON3FT Microcontroller

Table 380. GRSPWROUTER registers

RMAP address	Register name	Acronym
0x0000A44	Capability	RTR.CAP
0x0000A48 - 0x0000A4C	RESERVED	
0x0000A50	SpaceWire Plug-and-Play - Device Vendor and Product ID	RTR.PNPVEND
0x0000A54	SpaceWire Plug-and-Play - Unit Vendor and Product ID	RTR.PNPUVEND
0x0000A58	SpaceWire Plug-and-Play - Unit Serial Number	RTR.PNPUSN
0x0000A5C - 0x0000C0C	RESERVED	
0x0000C10, 0x0000C20	Outgoing character counter, ports [1, 2]	RTR.OCHARCNT
0x0000C14, 0x0000C24	Incoming character counter, ports [1, 2]	RTR.ICHARCNT
0x0000C18, 0x0000C28	Outgoing packet counter, ports [1, 2]	RTR.OPKTCNT
0x0000C1C, 0x0000C2C	Incoming packet counter, ports [1, 2]	RTR.IPKTCNT
0x0000D40 - 0x0000DFC	RESERVED	
0x0000E00 - 0x0000E0C	Maximum packet length, ports 0-3	RTR.MAXPLEN
0x0000E84 - 0x0000E88	Credit counter, ports 1-2	RTR.CREDCNT
0x0000F00	RESERVED	
0x0000F04	RESERVED	
0x0000F08 - 0x0000F0C	RESERVED	
0x0000F10	RESERVED	
0x0000F14 - 0x0000FFC	RESERVED	
0x00001000	RESERVED**	
0x00001004 - 0x0000100C	Routing table, combined port mapping and address control, addresses 1-3	RTR.RTCOMB
0x00001080 - 0x000013FC	RESERVED**	
0x00001400 - 0x00001FFC	RESERVED	
0x00002000 - 0x00002FFC	APB address area	RTR.APBAREA

\* Physical address 0 (configuration port), and non existing ports 4-31 does not have an RTR.RTPMAP or RTR.RTACTRL register, and are therefore RESERVED.

\*\* Physical address 0 (configuration port), and non existing 4-31 ports does not have an RTR.RTCOMB register, and are therefore RESERVED.

# LEON3FT Microcontroller

Table 381. 0x00000004-0x0000000C, 0x00000080-0x000003FC - RTR.RTPMAP - Routing table port mapping, addresses 1-3 and 32-255

31		4	3	2	1	0
	RESERVED		PE 1) 2) 3) 4)			PD
	0x000		*			0
	r		rw*			rw

31: 20 RESERVED

3: 1 Port enable bits (PE) - When set to 1, each bit enables packets with the physical / logical address corresponding to this RTR.RTPMAP register to be sent on the port with the same number as the bit index. For physical addresses, the bit index corresponding to the port with the same number as the physical address itself is always 1 (not possible to write to 0). For logical addresses, at least one bit must be set to 1 in order for a packet with the corresponding address to be routed; otherwise the packet is spilled and an invalid address error generated. Reset value for physical addresses is all zeroes (except for the bit index corresponding to the port with the same number as the address). Reset value for logical addresses is zero.

0 Packet distribution (PD) - When set to 1, packet distribution is used for the physical / logical address corresponding to this RTR.RTPMAP register. When set to 0, group adaptive routing is used. See section 33.2.4 and 33.2.5 for more information.

Note 1 GR716B can only be configured to have 1 logical address. Logical address in range 32 to 255 for GR716B is set via PE bits at selected address routing table position. E.g. to route packets with logical addresses of 64 to the AMBA port of the GR716B device application must set the PE bit in RTR.RTPMAP at the offset 0x160

Note 2 Setting PE bit for a specific logical address will automatically set PE = 0x1 for all lower logical addresses

Note 3 Setting PE bit for a specific logical address will automatically set PE = 0x2 for all higher logical addresses

Note 4 Selected logical address must be deselected before any new logical address can be set. Deselect current logical address by writing 0x0 to selected address routing table position.

Table 382. 0x00000404-0x0000040C, 0x00000480-0x000007FC - RTR.RTACTRL - Routing table address control, addresses 1-3 and 32-255

31		4	3	2	1	0
	RESERVED	SR	EN	PR	HD	
	0x0000000	*	*	*	*	
	r	rw	rw	rw	rw	

31: 4 RESERVED

3 Spill-if-not-ready (SR) - When set to 1, an incoming packet with the corresponding physical / logical address is immediately spilled if the selected output port's link interface is not in run-state. If packet distribution is used for the incoming packet, and this bit is set, the packet is spilled unless all output ports' link interfaces are in run state. For physical addresses, this bit is double mapped in the RTR.PCTRL.SR field. Reset value for physical addresses are taken from the SPILLIFNOTREADY pin. Reset value for logical addresses is N/R.

2 Enable (EN) - Enables the routing table address control entry. Address control entries for physical addresses are always enabled, and this field is constant 1. For logical addresses, this bit must be set to 1 in order for packets with the corresponding logical address to be routed. Reset value for logical addresses is 0.

1 Priority (PR) - Sets the arbitration priority of this physical / logical address. 0 = low priority, 1 = high priority. Used when more than one packet is competing for the same output port. For physical addresses, this bit is double mapped in the RTR.PCTRL.PR field. Reset value for physical addresses is 0. Reset value for logical addresses is N/R.

0 Header deletion (HD) - Enables / disabled header deletion for the corresponding logical address. For physical addresses, header deletion is always enabled, and this bit is constant 1. Reset value for logical addresses is N/R.

Note 1 Select logical address can only be configured after selected routing table position in RTR.RTPMAP has been set.

Note 2 Setting table address control bits for any logical address below selected routing table position in RTR.RTPMAP will affect all lower logical addresses

Note 3: Setting table address control bits for any logical address above selected routing table position in RTR.RTPMAP will affect all higher logical addresses

Note 4: logical address must be deselected in RTR.RTPMAP before new configuration of RTR.RTACTRL can be done

# LEON3FT Microcontroller

Table 383. 0x00000800 - RTR.PCTRLCFG - Port control, port 0 (configuration port)

31	18 17 16 15				10 9 8			0	
RESERVED				PL	TS	RESERVED		TR	RESERVED
0x0000				0	0	0x00		*	0x000
r				rw	rw	r		rw	r

- 31: 18 RESERVED
- 17 Packet length truncation (PL) - When set to 1, an RMAP / SpaceWire Plug-and-Play reply is spilled, and an EEP written to the transmit FIFO of the output port, if the total length of the reply packet exceeds the maximum length specified in the RTR.MAXPLEN register for port 0. See section 33.2.14 for more information on packet length truncation.
- 16 Time-code / distributed interrupt code truncation (TS) - When set to 1, an RMAP / SpaceWire Plug-and-Play reply is spilled, and an EEP written to the transmit FIFO of the output port, if a valid time-code / distributed interrupt code is received and if the code matches the codes selected by the RTR.PCTRL2CFG.SV and RTR.PCTRL2CFG.SM fields. See section 33.2.18 for more information.
- 15: 10 RESERVED
- 9 Timer enable (TR) - Enable data character timer for port 0. See section 33.2.13 for details. Reset value set from TIMEEN signal.
- 8: 0 RESERVED

Table 384. 0x00000804-0x0000080C - RTR.PCTRL - Port control, ports 1-3 SpaceWire ports

31	30	29	24 23 22 21 20 19 18 17 16 15 14												11 10 9 8 7 6 5 4 3 2 1 0								
RD		RES	ST	SR	AD	LR	PL	TS	IC	ET	RESERVED	DI	TR	PR	TF	RS	TE	R	CE	AS	LS	LD	
0x0		*	0x0	0	*	*	*	0	0	*	0	0x0	*	*	0	0	0	1	0	*	1	0	0
rw		r	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw

- 31: 24 Run-state clock divisor (RD) - Clock divisor value used for the corresponding port's link interface when in run-state. Field is only available for the SpaceWire ports. Bits 31:30 have reset value 0x0, while bits 29:24 get their reset value from the IDIVISOR[7:0] pins. For more information about setting the link-rate for SpaceWire ports during run-state see section 33.2.21.
- 23: 22 RESERVED
- 21 Static routing enable (ST) - When set to 1, incoming packets on this port are routed based on the physical address specified in the corresponding RTR.PCTRL2.SD field, and the setting of the corresponding RTR.PCTRL2.SC bit, instead of the packet's first byte. Header deletion is not used when static routing is enabled, which means that the first byte of the packet is always sent as well. This bit can only be set to 1 if the RTR.RTRCFG.SR bit is set to 1. Note that when this bit is set to 1 it is not possible to access the configuration port from this port.
- 20 Spill-if-not-ready (SR) - This bit is double mapping of the RTR.RTCTRL.SR bit. See table 382.
- 19 Auto-disconnect (AD) - When set to 1, the auto-disconnect feature described in section 33.2.12 is enabled. Reset value taken from the AUTODCONNECT pin. This bit is only available for the SpaceWire ports.
- 18 Link-start-on-request (LR) - When set to 1, the link-start-on-request feature described in section 33.2.11 is enabled. Reset value taken from the LINKSTARTONREQ pin. This bit is only available for the SpaceWire ports.
- 17 Packet length truncation (PL) - When set to 1, packets for which this port is the input port will be spilled, and an EEP written to the transmit FIFO of the output port(s), if the packets exceed the maximum length specified in the corresponding RTR.MAXPLEN register. See section 33.2.14 for more information on packet length truncation.
- 16 Time-code / distributed interrupt code truncation (TS) - When set to 1, packets for which this port is the input port will be spilled, and an EEP written to the transmit FIFO of the output port(s), if a valid time-code / distributed interrupt code is received, and if the code also matches the codes selected by the RTR.PCTRL2.SV and RTR.PCTRL2.SM fields. See section 33.2.18 for more information.

# LEON3FT Microcontroller

Table 384. 0x00000804-0x0000080C - RTR.PCTRL - Port control, ports 1-3 SpaceWire ports

15	Distributed interrupt code enable (IC) - When set to 0, all incoming distributed interrupt codes on this port are discarded, and no distributed interrupt codes are sent out on the port. When set to 1, the four bits RTR.PCTRL2.IR, RTR.PCTRL2.IT, RTR.PCTRL2.AR, RTR.PCTRL2.AT are used to enable / disable distributed interrupt code transmit and receive. Note that the global distributed interrupt code enable bit, RTR.CFG.IE, also must be set to 1 for distributed interrupt codes to be sent / received. See section 33.2.16 for a description of distributed interrupts. Reset value set from INTERRUPTFWD signal.
14	Enable external time (ET) - When a time-code is received on the port and this bit is set to 0, the router discards the received time-code value and instead increments its internal time-counter value (RTR.TC.TC), and forwards a time-code with the new value to the other ports. If this bit is set to 1 when the time-code is received, the time-code is processed according to the rules described in section 33.2.15. This bit is only available for the SIST port.
13: 11	RESERVED
10	Disable port (DI) - When set to 1, data transfers to and from this port are disabled. See section 33.2.6 for details. Reset value is 0 for SpaceWire ports, and 1 for SIST port. NOTE: If this bit is set in combination with the RTR.PCTRL.LD bit, the link interface for this port will be clock gated, and the LVDS drivers for this port will be powered-down.
9	Packet timer enable (TR) - Enable the data character timer for incoming packets. See section 33.2.13 for details. Reset value set from TIMEREN signal.
8	Priority (PR) - This bit is double mapping of the RTR.RTCTRL.SR bit. See table 382.
7	Transmit FIFO reset (TF) - Resets the transmit FIFO on this port. This means that the FIFO is emptied (counters and pointers set to 0), and an EEP is written to the FIFO to ensure that any incomplete packet is detected by the receiver. If a packet transmission is active (another port is using this port as output port) when this bit is set, the remainder of that packet will be spilled before the EEP is inserted. This bit is self-clearing, and should not be written with 0 while it is 1, since that could abort the ongoing transmit FIFO reset.
6	Receive FIFO spill (RS) - Spills the receive FIFO for this port, meaning that the packet currently being received is spilled. The output port(s) used for the packet will have an EEP written to the transmit FIFO to indicate that the packet was ended prematurely. If no packet is received, setting this bit has no effect. This bit is self-clearing, and should not be written with 0 while it is 1, since that could abort the ongoing receive FIFO spill.
5	Time-code enable (TE) - Enables time-codes to be received and transmitted on this port. When set to 1, received time-codes are processed according to the rules described in section 33.2.15. If this bit is set to 0, all received time-codes on this port are ignored.
4	RESERVED
3	Configuration port access enable (CE) - Enable accesses to the configuration port from this port. If set to 0, incoming packets with physical address 0 will be spilled. Reset value is 1 for SpaceWire ports, and 0 for SIST port.
2	Autostart (AS) - Enable the link interface FSM's autostart feature, as defined in ECSS-E-ST-50-12C [SPW]. This bit is only available for the SpaceWire ports.
1	Link start (LS) - Start the link interface FSM. This bit is only available for the SpaceWire ports.
0	Link disabled (LD) - Disable the link interface FSM. This bit is only available for the SpaceWire ports. NOTE: When this bit is set to 1, the LVDS driver for this SpaceWire port will be powered down. If this bit is set in combination with the RTR.PCTR.DI bit, the link interface will be clock gated.

# LEON3FT Microcontroller

Table 385. 0x00000880 - RTR.PSTSCFG - Port status, port 0 (configuration port)

31	30	29	28	27	26	25	24	23	20	19	18	17	12	11	7	6	5	4	3	0
EO	EE	PL	TT	PT	HC	PI	CE	EC	R	TS	RESERVED			IP	RES	CP	PC			
0	0	0	0	0	0	0	0	0x0	0	0	0x00			0x0	0x0		0x0			
wc	wc	wc	wc	wc	wc	wc	rw*	r	r	wc	r			r	r	rw*	r			

- 31 Early EOP (EO) - Set to 1 when an RMAP / SpaceWire Plug-and-Play command with an early EOP was received by the configuration port. See section 33.5.1.4 for error detection order.
- 30 Early EEP (EE) - Set to one when an RMAP / SpaceWire Plug-and-Play command with an early EEP was received by the configuration port. See section 33.5.1.4 for error detection order.
- 29 Packet length truncation (PL) - Set to 1 when an RMAP / SpaceWire Plug-and-Play reply packet has been spilled due to a maximum length violation. See section 33.2.14 for details.
- 28 Time-code / distributed interrupt code tick truncation (TT) - Set to one when an RMAP / SpaceWire Plug-and-Play reply packet has been spilled due to a time-code / distributed interrupt code. See section 33.2.18 for details.
- 27 Packet type error (PT) - Set to one if an RMAP / SpaceWire Plug-and-Play packet with correct header CRC, but with the packet type bits set to the reserved values “10” or “11”, was received by the configuration port. See section 33.5.1.4 for error detection order.
- 26 Header CRC Error (HC) - Set to one if a Header CRC error is detected in an RMAP / SpaceWire Plug-and-Play command received by the configuration port. See section 33.5.1.4 for error detection order.
- 25 Protocol ID Error (PI) - Set to one if a packet received by the configuration port had the wrong protocol ID. Supported protocol ID:s are 0x01 (RMAP), and 0x03 (SpaceWire Plug-and-Play). See section 33.5.1.4 for error detection order.
- 24 Clear error code (CE) - Write with a 1 to clear the RTR.PCTRLCFG.EC field. This bit is self clearing and always reads 0. Writing 0 has no effect.
- 23: 20 Error code (EC) - Shows the four least significant bits of the latest non-zero RMAP status code. If zero, no error has occurred.
- 19 RESERVED
- 18 Timeout spill (TS) - Set to one when an RMAP reply was spilled due to a packet timeout. See section 33.2.13 for details.
- 17: 12 RESERVED
- 11: 7 Input port (IP) - The number of the last port from which a packet was routed to the configuration port. This field is updated even if an operation is not performed, for example due to an incorrect RMAP packet.
- 6: 5 RESERVED
- 4 Clear SpaceWire Plug-and-Play error code (CP) - Write with a 1 to clear the RTR.PCTRLCFG.PC field. This bit is self clearing and always reads 0. Writing 0 has no effect.
- 3: 0 SpaceWire Plug-and-Play Error code (PC) - Shows the four least significant bits of the latest non-zero SpaceWire Plug-and-Play status code. If zero, no error has occurred.

Table 386. 0x00000884-0x0000088C - RTR.PSTS - Port status, ports 1-3

31	30	29	28	27	26	25	23	22	21	20	19	18	17	16	15	14	12	11	7	6	5	4	3	2	1	0
PT	PL	TT	RS	SR	RESERVED	LR	SP	AC	R	TS	R	TF	RE	LS	IP			PR	PB	IA	CE	ER	DE	PE		
*	0	0	0	0	0x0	0	0	0	0	0	0	0	0	1	000	00000			0	0	0	0	0	0	0	
r	wc	wc	wc	wc	r	r	r	r	r	wc	r	r	r	r	r			r	r	wc	wc	wc	wc	wc	wc	

- 31: 30 Port type (PT) - The type of this port. Constant value of “00” for the SpaceWire ports, and constant value of “11” for the SIST port.
- 29 Packet length truncation (PL) - Set to 1 when a packet for which this port was the input port has been spilled due to the packet length truncation feature. See section 33.2.14 for details.
- 28 Time-code / distributed interrupt code tick truncation (TT) - Set to 1 when a packet for which this port was the input port has been spilled due to the time-code / distributed interrupt code truncation feature. See section 33.2.18 for details.

# LEON3FT Microcontroller

Table 386. 0x00000884-0x0000088C - RTR.PSTS - Port status, ports 1-3

27	RMAP / SpaceWire Plug-and-Play spill (RS) - Set to 1 when an RMAP / SpaceWire Plug-and-Play command received on this port was spilled by the configuration port.
26	Spill-if-not-ready spill (SR) - Set to 1 when a packet received on this port was spilled due to the spill-if-not-ready feature. See section 33.2.8.
25: 23	RESERVED
22	Link-start-on-request status (LR) - Set to 1 when this port either was started, or currently is trying to start, due to the link-start-on-request feature, described in section 33.2.11. This bit is only available for the SpaceWire ports.
21	Spill status (SP) - This bit is 1 when a packet that is incoming on this port currently is being spilled. Otherwise, this bit is 0.
20	Active status (AC) - Set to 1 when a packet arrives at this port and the port has been given access to the routing table. Cleared when the packet has been transmitted or spilled.
19	RESERVED
18	Timeout spill (TS) - Set to 1 when a packet for which this port was the input port was spilled due to a packet timeout. See section 33.2.13 for details.
17	RESERVED
16	Transmit FIFO full (TF) - Set to 1 when the transmit FIFO on this port is full.
15	Receive FIFO empty (RE) - Set to 1 when the receive FIFO on this port is empty.
14: 12	Link state (LS) - Current link state. 000 = Error reset, 001 = Error wait, 010 = Ready, 011 = Started, 100 = Connecting, 101 = Run state. This field is only available for the SpaceWire ports.
11: 7	Input port (IP) - This field shows the number of the input port for either the currently ongoing packet transfer on this port (if RTR.PSTS.PB = 1), or for the last packet transfer on this port (if RTR.PSTS.PB = 0).
6	Port receive busy (PR) - Set to 1 when this port is the input port of an ongoing packet transfer.
5	Port transmit busy (PB) - Set to 1 when this port is the output port of an ongoing packet transfer.
4	Invalid address (IA) - Set to 1 when an invalid address error occurred on this port. See section 33.2.10 for details.
3	Credit error (CE) - Set to 1 when a credit error has occurred. This bit is only available for the SpaceWire ports.
2	Escape error (ER) - Set to 1 when an escape error has occurred. This bit is only available for the SpaceWire ports.
1	Disconnect error (DE) - Set to 1 when a disconnect error has occurred. This bit is only available for the SpaceWire ports.
0	Parity error (PE) - Set to 1 when a parity error has occurred on. This bit is only available for the SpaceWire ports.

Table 387. 0x00000900-0x0000090C - RTR.PTIMER - Port timer reload, ports 0-3

31	RESERVED	10 9	RL	0
*				
rw*				

31: 10	RESERVED
9: 0	Timer reload (RL) - Port timer reload value, counted in prescaler ticks. This value is used to reload the corresponding port timer used for packet transfer timeouts, and auto-disconnect. The minimum value of this field is 1. Trying to write 0 will result in 1 being written. Reset value set from RELOADN[31:0] signal.

# LEON3FT Microcontroller

Table 388. 0x00000980 - RTR.PCTRL2CFG - Port control 2, port 0 (configuration port)

31	24	23	16	15	14	13	12	11	10	9	8	6	5	1	0
SM			SV			OR	RESERVED								
0xC0			0x00			1	0x0000								
rw			rw			rw	r								

- 31: 24 Time-code / distributed interrupt code truncation mask (SM) - Defines which bits of a time-code / distributed interrupt code that must match the value specified in RTR.PCTRL2CFG.SV in order for an RMAP / SpaceWire Plug-and-Play reply packet to be spilled. If a bit in this field is set to 1, the corresponding bit in RTR.PCTRL2.SV must match the time-code / distributed interrupt code. If a bit in this field is set to 0, the corresponding bit in RTR.PCTRL2.SV does not have to match the time-code / distributed interrupt code.
- 23: 16 Time-code / distributed interrupt code truncation value (SV) - Defines the value to use together with the RTR.PCTRL2CFG.SM field when checking if a received time-code / distributed interrupt code should spill an ongoing RMAP / SpaceWire Plug-and-Play reply.
- 15 Overrun timeout enable (OR) - Enables spilling due to overrun timeouts for RMAP / SpaceWire Plug-and-Play replies. See section 33.2.13 for details.
- 14: 0 RESERVED

Table 389. 0x00000984-0x0000098C - RTR.PCTRL2 - Port control 2, ports 1-3

31	24	23	16	15	14	13	12	11	10	9	8	6	5	1	0
SM			SV			OR	UR	R	AT	AR	IT	IR	RESERVED	SD	SC
0xC0			0x00			1	1	0	1	1	1	1	0x0	0x00	0
rw			rw			rw	rw	r	rw	rw	rw	rw	r	rw	rw

- 31: 24 Time-code / distributed interrupt code truncation mask (SM) - Defines which bits of a time-code / distributed interrupt code that must match the value specified in RTR.PCTRL2.SV in order for a packet, for which this port is the input port, to be spilled. If a bit in this field is set to 1, the corresponding bit in RTR.PCTRL2.SV must match the time-code / distributed interrupt code. If a bit in this field is set to 0, the corresponding bit in RTR.PCTRL2.SV does not have to match the time-code / distributed interrupt code.
- 23: 16 Time-code / distributed interrupt code truncation value (SV) - Defines the value to use together with the RTR.PCTRL2.SM field when checking if a time-code / distributed interrupt code should spill a packet for which this port is the input port.
- 15 Overrun timeout enable (OR) - Enables spilling due to overrun timeouts for packets for which this port is the input port. See section 33.2.13 for details.
- 14 Underrun timeout enable (UR) - Enables spilling due to unerrun timeouts for packets for which this port is the input port. See section 33.2.13 for details.
- 13 RESERVED
- 12 Interrupt acknowledgement code / extended interrupt code transmit enable (AT) - Enables the transmission of interrupt acknowledgement codes / extended interrupt codes on this port. If set to 0, no interrupt acknowledgement codes / extended interrupt codes will be forwarded to this port.
- 11 Interrupt acknowledgement code / extended interrupt code receive enable (AR) - Enabled the reception of interrupt acknowledgement codes / extended interrupt codes on this port. If set to 0, all received interrupt acknowledgement codes / extended interrupt codes on this port will be silently discarded.
- 10 Interrupt code transmit enable (IT) - Enables the transmission of interrupt codes on this port. If set to 0, no interrupt codes will be forwarded to this port.
- 9 Interrupt code receive enable (IR) - Enabled the reception of interrupt codes on this port. If set to 0, all received interrupt codes on this port will be silently discarded.
- 8: 6 RESERVED
- 5: 1 Static route destination (SD) - When RTR.PCTRL.ST is set to 1, incoming packets on this port will be routed based on the value of this field, and the setting of RTR.PCTRL2.SC, instead of the packet's first byte.
- 0 Static route configuration (SC) - When this bit is set to 1, the RTR.RTPMAP register corresponding to the physical address specified by the RTR.PCTRL2.SD field will be used when routing packets, if RTR.PCTRL.ST is set to 1.



# LEON3FT Microcontroller

Table 390. 0x00000A00 - RTR.RTRCFG - Router configuration / status

31	27	26	22	21	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
SP	RESERVED				FP	R	SR	PE	IC	IS	IP	AI	AT	IE	RE	EE	AA	SA	TF	R	TA	PP	
0x12	0x00				0x01	0	*	*	0	0	0	*	1	*	0	*	*	1	*	0	1	1	
r	r				r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r

- 31: 27 SpaceWire ports (SP) - Set to the number of SpaceWire ports in the router. Constant value of 0x12.
- 26: 22 RESERVED
- 21: 17 FIFO ports (FP) - Set to the number of FIFO ports. Constant value of 0x01.
- 16 RESERVED
- 15 Static routing enable (SR) - This read-only bit specifies if the router's static routing feature is enabled (1) or disabled (0). See section 33.2.7 for details. The value is set from the STATICROUTEEN signal at reset.
- 14 SpaceWire Plug-and-Play enable (PE) - This read-only bit specifies if the router's SpaceWire Plug-and-Play features are enabled (1) or disabled (0). See section 33.6.1 for details. The value is set from the PNPEN pin at reset.
- 13 ISR change timer enable (IC) - If set to 1, the router will wait for the time period specified by the RTR.IRC-TIMER register after an ISR bit change value, before it allows an incoming distributed interrupt code to change the value of the same ISR bit. If set to 0, the ISR change timers are not used, and an ISR bit is allowed to change value again as soon as the previous distributed interrupt code has been distributed.
- 12 Distributed interrupt code selection routine (IS) - If set to 0, the router uses round-robin on the interrupt numbers when deciding which distributed interrupt code to distribute next. If set to 1, the router gives priority to lower interrupt numbers when deciding which distributed interrupt code to distribute. See section 33.2.16.1.
- 11 Distributed interrupt code priority (IP) - When set to 0, all interrupt codes have priority over all interrupt acknowledgement codes / extended interrupt codes, and will be distributed first. When set to 1, all interrupt acknowledgement codes have priority over all interrupt codes. See section 33.2.16.1.
- 10 Auxiliary distributed interrupt codes enable (AI) - If set to 1, distributed interrupt codes can be sent and received on the auxiliary time-code / distributed interrupt code interface. If set to 0, all distributed interrupt codes received on the auxiliary interface are silently discarded, and no distributed interrupt codes will be transmitted on the interface. Reset value set from INTERRUPTFWD signal.
- 9 Auxiliary time-code enable (AT) - If set to 1, time-codes can be sent and received on the auxiliary time-code / distributed interrupt code interface. If set to 0, all time-codes received on the auxiliary interface are silently discarded, and no time-codes will be transmitted on the interface.
- 8 Distributed interrupt codes enable (IE) - Global enable/disable for distributed interrupt codes. If set to 0, all received distributed interrupt codes will either be silently discarded (if RTRCFG.TF = 1), or handled as time-codes (if RTRCFG.TF = 0). When set to 1, whether or not distributed interrupt codes are received or transmitted on a port depends on the setting of the register bits RTR.PCTRL.IC, RTR.PCTRL2.IR, RTR.PCTRL2.IT, RTR.PCTRL2.AR, and RTR.PCTRL2.AT. Reset value taken from INTERRUPTCODEEN signal.
- 7 Reset (RE) - Resets the complete router when written with a 1. When this bit is written through RMAP, an RMAP reply will not be sent, even if the reply bit in the RMAP commands Instruction field is set to 1. This bit is self-clearing.
- 6 Enable extended distributed interrupts (EE) - If set to 0, all distributed interrupt codes with bit 5 set to 1 are handled as interrupt acknowledgement codes. If set to 1, all distributed interrupt codes with bit 5 set to 1 are handled as extended interrupt code. Reset value taken from INTERRUPTMODE signal. See section 33.2.16.
- 5 Asynchronous auxiliary interface (AA) - This read-only bit specifies whether the inputs of the auxiliary time-code / distributed interrupt code interface, described in section 33.2.17, are handled as synchronous or asynchronous to CLK. A value of 0 means that the inputs are handles as synchronous to CLK, while 1 means asynchronous.
- 4 Self addressing enable (SA) - If set to 1, ports are allowed to send packets to themselves. If set to 0, packets with the same input port as output port are spilled, and an invalid address error is asserted for that port.
- 3 Time-code control flag mode (TF) - When set to 0, all received time-codes / distributed interrupt codes are handled as time-codes, no matter the value of the control flags (bits 7:6 of the code). When set to 1, the time-code control flags must have value "00" to be considered valid time-codes. Note that the RTRCFG.IE bit has priority over this bit, which means that if RTRCFG.IE is 1, then setting this bit to 0 has no impact. Reset value taken from TIMECODEFILT.
- 2 RESERVED

# LEON3FT Microcontroller

Table 390. 0x00000A00 - RTR.RTRCFG - Router configuration / status

- 1 Timers available (TA) - Constant value 1. Indicates that the router has support for timers, as described in section 33.2.13.
- 0 SpaceWire Plug and Play available (PP) - Constant value 1. Indicates that the router support SpaceWire Plug and Play, as described in section 33.6.1.

Table 391. 0x00000A04 - RTR.TC - Time-code

31	10	9	8	7	6	5	0
RESERVED	RE	EN	CF	TC			
0x000000	0	*	0x0	0x00			
r	rw*	rw	r	r			

- 31: 10 RESERVED
- 9 Reset time-code (RE) - When this field is written to 1, the RTR.TC.CF and RTR.TC.TC fields are reset. This bit is self-clearing, and always reads 0. Writing 0 has no effect.
- 8 Enable time-codes (EN) - When set to 1, received time-codes are handled by the router according to the rules described in 33.2.15. When set to 0, all received time-codes are silently discarded. Reset value set through TIMECODEREGEN signal.
- 7: 6 Time-control flags (CF) - The current value of the router's time-code control flags (bits 7:6 of the latest valid time-code received).
- 5: 0 Time-counter (TC) - Current value of the router's time counter.

Table 392. 0x00000A08 - RTR.VER - Version / instance ID

31	24	23	16	15	8	7	4	3	0
MA	MI		PA		ID				
0x01	0x03		0x00		*				
r	r		r		rw				

- 31: 24 Major version (MA) - Holds the major version number of the router. Constant value 0x01.
- 23: 16 Minor version (MI) - Holds the minor version number of the router. Constant value 0x03.
- 15: 8 Patch (PA) - Holds the patch number of the router. Constant value 0x00.
- 7: 0 Instance ID (ID) - Holds the instance ID number of the router. Reset value is set through INSTANVEID[7:0] signal.

Table 393. 0x00000A0C - RTR.IDIV - Initialization divisor

31	8	7	0
RESERVED	ID		
0x000000	*		
r	rw		

- 31: 8 RESERVED
- 7: 0 Initialization clock divisor (ID) - Clock divisor value used by all the SpaceWire links to generate the 10 Mbit/s rate during initialization. Reset value from the IDIVISOR[7:0] signal. For more information about setting the link-rate for SpaceWire ports during initialization see section 33.2.21.

# LEON3FT Microcontroller

Table 394. 0x00000A10 - RTR.CFGWE - Configuration port write enable

31	RESERVED	1	0
	0x00000000		WE
	r		rw

- 31: 1 RESERVED
- 0 Configuration port write enable (WE) - When set to 1, write accesses to the configuration port area are allowed. When set to 0, write accesses are only allowed to this register. RMAP write and RMAP read-modify-write commands will be replied to with the Status field set to 0x0A (authorization failure), if a reply was requested. The value of this bit has no effect for SpaceWire Plug-and-Play commands.

Table 395. 0x00000A14 - RTR.PRESCALER - Timer prescaler reload

31	16	15	0
	RL		
	*		
	rw*		

- 31: 0 Timer prescaler reload (RL) - Global prescaler reload value used for generating a common tick for the data character timers, auto-disconnect timers, and distributed interrupt code timers. The prescaler runs on the system clock, and a tick is generated every RTR.PRESCALER.RL+1 CLK cycle. The minimum value of this field is 49. Trying to write a value less than that will result in 49 being written. Reset value is set through RELOAD[31:0] signal.

Table 396. 0x00000A18 - RTR.IMASK - Interrupt mask

31	11	10	9	8	7	6	5	4	3	2	1	0
	RESERVED											
	0x00000											
		PE	SR	RS	TT	PL	TS	AC	RE	IA	LE	R
		0	0	0	0	0	0	0	0	0	0	0
		rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r

- 31: 11 RESERVED
- 10 SpaceWire Plug-and-Play error (PE) - Generate an interrupt when a SpaceWire Plug and Play error has been detected in the configuration port. The different errors are described in 33.6.1.
- 9 Spill-if-not-ready (SR) - Generate an interrupt when a packet has been spilled because of the spill-if-not-ready feature described in section 33.2.8.
- 8 Run-state entry (RS) - Generate an interrupt when a SpaceWire link enters run-state.
- 7 Time-code / distributed interruptcode tick truncation (TT) - Generate an interrupt when a packet has been spilled because of the time-code / distributed interrupt code truncation feature described in section 33.2.18.1.
- 6 Packet length truncation (PL) - Generate an interrupt when a packet has been spilled due to the packet length truncation feature described in section 33.2.14.
- 5 Timeout spill (TS) - Generate an interrupt when a packet has been spilled due to the timeout mechanism.
- 4 Auxiliary configuration port error (AC) - Generate an interrupt when either a header CRC error, protocol ID error, packet type error, early EOP, or early EEP has been detected in the configuration port.
- 3 RMAP error (RE) - Generate an interrupt when an error has been detected in the configuration port for an RMAP command such that the PSTS.EC field is set to a non-zero value.
- 2 Invalid address (IA)- Generate an interrupt when an invalid address error has occurred on a port. See RTR.PSTS:IA bit and section 33.2.10 for a definition of invalid address.
- 1 Link error (LE) - Generate an interrupt when a link error has been detected on a SpaceWire port.
- 0 RESERVED

# LEON3FT Microcontroller

Table 397. 0x00000A1C - RTR.IPMASK - Interrupt port mask

31	20 19	0
RESERVED	IE	
0x000	0x00000	
r	rw	

- 31: 20    RESERVED
- 19: 0    Port interrupt enable (IE) - Set a bit to 1 to enable interrupts to be generated for an error detected in the port with the same number as the bit index. An interrupt is signaled through the IRQ pin, and optionally through a distributed interrupt code.

Table 398. 0x00000A20 - RTR.PIP - Port interrupt pending

31	20 19	0
RESERVED	IP	
0x000	0x00000	
r	wc	

- 31: 20    RESERVED
- 19: 0    Interrupt pending (IP) - When a bit is set to 1, the port with the same number as the bit index was the source of an interrupt. A bit in this field will only be set to 1 for a generated interrupt if the port's corresponding bit in RTR.IPMASK is set, as well as the error types corresponding bit in RTR.IMASK, are set.

Table 399. 0x00000A24 - RTR.ICODEGEN - Interrupt code generation

31	21 20 19 18 17 16 15	6 5	0
RESERVED	UA AH IT TE EN	RESERVED	IN
0x000	0 0 0 1 0	0x000	0x00
r	rw rw rw rw rw	r	rw

- 31: 21    RESERVED
- 20    Interrupt code generation un-acknowledge mode (UA) - If this bit is set to 1, an ISR timeout for a distributed interrupt that was generated by the router will clear the bits in the RTR.PIP register that were set when the interrupt was generated. If this bit is set to 0, no extra handling is done on an ISR timeout event, and the bits in RTR.PIP will stay set. See section 33.2.16.
- 19    Interrupt acknowledgement code handling (AH) - When set to 1, and the router has generated an interrupt code, a received interrupt acknowledgement code with the interrupt number matching the RTR.ICODEGEN.IN field will clear the bits in the RTR.PIP register that were set when the interrupt code was generated. If set to 0, no extra handling of a received interrupt acknowledgement code is done and the bits in RTR.PIP will stay set. This bit is unused when the distributed interrupts are operating in the extended interrupt mode. See section 33.2.16.
- 18    Interrupt type (IT) - 0 = Level. 1 = Edge. When set to 0, a new interrupt code is distributed as long as RTR.PIP register is non zero. When set to 1, a new interrupt code is distributed only when a bit in RTR.PIP toggles from 0 to 1. See section 33.2.16.

# LEON3FT Microcontroller

*Table 399. 0x00000A24 - RTR.ICODEGEN - Interrupt code generation*

- 17 Interrupt acknowledgement code to interrupt code timer enable (TE) - If set to 1, the router will wait for the time period specified by the RTR.AITIMER register after the reception of an interrupt acknowledgement code (for which the router generated the corresponding interrupt code) until a new interrupt code is allowed to be generated. If set to 0, the timer is not used, and a new interrupt code is allowed to be generated as soon as the interrupt acknowledgement code has been distributed. This bit is unused when the distributed interrupts are operating in the extended interrupt mode.
- 16 Interrupt code generation enable (EN) - When 1, distributed interrupt code generation is enabled, and an interrupt code / extended interrupt code can be generated when an internal error event occurs. See section 33.2.16.
- 15: 6 RESERVED
- 5: 0 Interrupt number (IN) - Sets the interrupt number of the distributed interrupt code that will be generated when the interrupt code generation feature is enabled (RTR.ICODEGEN.EN = 1). Note that when the distributed interrupts are operating in interrupt with acknowledgements mode, this field must not be set to a value larger than 31, since that would specify an interrupt with acknowledgement code. See section 33.2.16.

*Table 400. 0x00000A28 - RTR.ISR0 - Interrupt code distribution ISR register, interrupt 0-31*

31	0
IB	
0x00000000	
wc	

- 31: 0 Distributed interrupt code ISR bits (IB) - The current value of the distributed interrupt code ISR register for interrupt numbers 0 to 31. Each bit index corresponds to the ISR bit value for the corresponding interrupt number. A bit value of 1 indicates that an interrupt code with the corresponding interrupt number has been received, but not yet acknowledged. A bit value of 0 indicates either that no interrupt code with the corresponding interrupt number has been received, or that the previous interrupt code was either acknowledged or timed out. This register should be normally only be used for diagnostics and / or FDIR.

*Table 401. 0x00000A28 - RTR.ISR1 - Interrupt code distribution ISR register, interrupt 32-63*

31	0
IB	
0x00000000	
wc	

- 31: 0 Distributed interrupt code ISR bits (IB) - The current value of the distributed interrupt code ISR register for interrupt numbers 32 to 63. Each bit index + 32 corresponds to the ISR bit value for the corresponding interrupt number. A bit value of 1 indicates that an extended interrupt code with the corresponding interrupt number has been received. A bit value of 0 indicates either that no extended interrupt code with the corresponding interrupt number has been received, or that the previous interrupt code has timed out. Note that if the distributed interrupts are operating in interrupt with acknowledgements mode, this register is unused. This register should be normally only be used for diagnostics and / or FDIR.

*Table 402. 0x00000A30 - RTR.ISRTIMER - Interrupt code distribution ISR timer reload*

31	0
RL	
*	
rw	

- 31: 0 Interrupt code distribution ISR timer reload (RL) - Interrupt code distribution ISR timer reload value, counted in prescaler ticks. Each ISR bit has its own timer, which is started and reloaded with the value of this field when an interrupt code / extended interrupt code with the corresponding interrupt number is received (or generated by the router). Reset value is set through IRQTIMEOUTRELOAD[31:0] pins. See section 33.2.16 for details on interrupt code distribution.

# LEON3FT Microcontroller

Table 403. 0x00000A34 - RTR.AITIMER - Interrupt code distribution ACK-to-INT timer reload

31	0
RL	
*	
rw	

31: 0 Interrupt acknowledgement code to interrupt code timer reload (RL) - Interrupt acknowledgement code to interrupt code timer reload value, counted in prescaler ticks. When an interrupt acknowledgement code is received - for which the router generated the corresponding interrupt code - the interrupt acknowledgement code to interrupt code timer is started and reloaded with the value of this field. Reset value is set through IRQGENRELOAD[31:0] signal. This register is unused when the distributed interrupts are operating in the extended interrupt mode. See section 33.2.16 for details on interrupt code distribution.

Table 404. 0x00000A38 - RTR.ISRCTIMER - Interrupt code distribution ISR change timer reload

31	0
RL	
0	
rw	

31: 0 Interrupt code distribution ISR change timer reload (RL) - Interrupt code distribution ISR change timer reload value, counted in prescaler ticks. Each time an ISR bit change value, the corresponding ISR change timer is started and reloaded with the value of this field. See section 33.2.16 for details on interrupt code distribution.

Table 405. 0x00000A40 - RTR.LRUNSTAT - Link running status

31	19 18	1 0
RESERVED	LR	R
0x0000	0x00000	0
r	r	r

31: 19 RESERVED

18: 1 Link running status (LR)- Each bit is set to 1 when the link interface for the SpaceWire port with the same number as the bit index is in run-state. If the link interface is not in run-state, the bit is set to 0.

0 RESERVED

Table 406. 0x00000A44 - RTR.CAP - Capability

31	26 25 24 23 22	20 19 18	16 15 14 13 12 11 10 9	5 4	0						
RESERVED	PF	R	RM	R	AA	AX	R	ID	SD	PC	CC
0x000	0x2	0	0x5	0	1	1	0	1	1	0x1F	0x1F
r	r	r	r	r	r	r	r	r	r	r	r

31: 23 RESERVED

22: 20 Port N-char FIFO size (PF) - The number of entries in the port FIFOs can be determined by the value of this field, according to the formula: Entries =  $2^{(RTR.CAP.PF+4)}$ . Constant value of 0x2 = 64 entries.

19 RESERVED

18: 16 RMAP maximum data length (RM) - This field specifies the maximum data length in an RMAP read / write command that the configuration port can handle. The length can be determined according to the formula: Length =  $2^{(RTR.CAP.RM+2)}$ . Constant value of 0x5 = 128 bytes.

15 RESERVED

# LEON3FT Microcontroller

Table 406. 0x00000A44 - RTR.CAP - Capability

14	Asynchronous axiliary time-code / distributed interrupt code support (AA) - Specifies that the router has support for the auxiliary time-code / distributed interrupt code interface inputs to be asynchronous to CLK. See section 33.2.15. Constant value of 1.
13	Auxiliary time-code / distributed interrupt code support (AX) - Specifies that the router has support for the auxiliary time-code / distributed interrupt code feature described in 33.2.15. Constant value of 1.
12	RESERVED
11	Distributed interrupt code support (ID) - Specifies that the router has support for the interrupt distribution scheme, described in 33.2.16. Constant value of 1.
10	SpaceWire-D support (SD) - Specifies that the router has support for the SpaceWire-D, described in section 33.2.18. Constant value of 1.
9: 5	Port packet counter bits (PC) - Specifies the number of bits in the port's incoming / outgoing packet counters. Constant value of 0x1F = 31 bits
4: 0	Port character counter bits (CC) - Specifies the number of bits in the port's incoming / outgoing character counters. Constant value of 0x1F = 31 bits

Table 407. 0x00000A50 - RTR.PNPVEND - SpaceWire Plug-and-Play - Device Vendor and Product ID

31	16	15	0
VI		PI	
0x0003		0x0718	
r		r	

- 31: 16 SpaceWire Plug-and-Play Vendor ID (VI) - Double mapping of the VEND bits from the SpaceWire Plug-and-Play Device Vendor and Product ID field. See table 420.
- 25: 0 SpaceWire Plug-and-Play Product ID (PI) - Double mapping of the PROD bits from the SpaceWire Plug-and-Play Device Vendor and Product ID field. See table 420.

Table 408. 0x00000A54 - RTR.PNPUVEND - SpaceWire Plug-and-Play - Unit Vendor and Product ID

31	16	15	0
VI		PI	
0x0000		0x0000	
rw		rw	

- 31: 16 SpaceWire Plug-and-Play Unit vendor ID (VI) - Double mapping of the VEND bits from the SpaceWire Plug-and-Play Unit Vendor and Product ID field (see table 429).
- 25: 0 SpaceWire Plug-and-Play Unit product ID (PI) - Double mapping of the PROD bits from the SpaceWire Plug-and-Play Unit Vendor and Product ID field (see table 429).

Table 409. 0x00000A58 - RTR.PNPUSN - SpaceWire Plug-and-Play - Unit Serial Number

31	8	7	0
SN			
0x000000			*
rw			

- 31: 0 SpaceWire Plug-and-Play Unit serial number (SN) - Double mapping of the SpaceWire Plug-and-Play Unit Serial Number field (see table 430). Reset value for bits 3:0 is set through INSTANCEID[7:0] signal.

# LEON3FT Microcontroller

Table 410. 0x00000C10,0x00000C20...0x00000D30 - RTR.OCHARCNT - Outgoing character counter, ports 1-19

31	30		0
OR		CC	
0		0x00000000	
wc		rw*	

- 31 Counter overrun (OR) - This bit is set to 1 when the character counter (RTR.OCHARCNT.CC) overflows. A write with a 1 to this field will clear the whole character counter (including this bit)
- 30: 0 Character counter (CC) - Number of data characters (EOP, EEP, time-codes, distributed interrupt codes are not included) that have been transmitted on the corresponding port. When the counter reaches its maximum value, it sets the RTR.OCHARCNT.OR bit to 1 and continue counting from zero. A write to this field where bit 30 is set to 1 will reset the RTR.OCHARCNT.OR bit. A write to this field where bit 30 is set to 0 has no effect.

Table 411. 0x00000C14,0x00000C24...0x00000D34 - RTR.ICHARCNT - Incoming character counter, ports 1-19

31	30		0
OR		CC	
0		0x00000000	
wc		rw*	

- 31 Counter overrun (OR) - This bit is set to 1 when the character counter (RTR.ICHARCNT.CC) overflows. A write with a 1 to this field will the whole character counter (including this bit)
- 30: 0 Character counter (CC) - Number of data characters (EOP, EEP, time-codes, distributed interrupt codes are not included) that have been received on the corresponding port. When the counter reaches its maximum value, it sets the RTR.ICHARCNT.OR bit to 1 and continue counting from zero. A write to this field where bit 30 is set to 1 will reset the RTR.ICHARCNT.OR bit. A write to this field where bit 30 is set to 0 has no effect.

Table 412. 0x00000C18,0x00000C28...0x00000D38 - RTR.OPKTCNT - Outgoing packet counter, ports 1-19

31	30	29	0
OR		PC	
0		0x00000000	
wc		rw*	

- 31 Counter overrun (OR) - This bit is set to 1 when the packet counter (RTR.OPKTCNT.PC) overflows. A write with a 1 to this field will reset the whole character counter (including this bit).
- 30: 0 Packet counter (PC) - Number of packets that have been transmitted on the corresponding port. When the counter reaches its maximum value, it sets the RTR.OPKTCNT.OR bit to 1 and continue counting from zero. A write to this field where bit 30 is set to 1 will reset the RTR.OPKTCNT.OR bit. A write to this field where bit 30 is set to 0 has no effect.

Table 413. 0x00000C1C,0x00000C2C...0x00000D3C - RTR.IPKTCNT - Incoming packet counter, ports 1-19

31	30	29	0
OR		PC	
0		0x00000000	
wc		rw*	



# LEON3FT Microcontroller

*Table 413. 0x00000C1C,0x00000C2C...0x00000D3C - RTR.IPKTCNT - Incoming packet counter, ports 1-19*

- 31 Counter overrun (OR) - This bit is set to 1 when the packet counter (RTR.IPKTCNT.PC) overflows. A write with a 1 to this field will reset the whole character counter (including this bit).
- 30: 0 Packet counter (PC) - Number of packets that have been received on the corresponding port. When the counter reaches its maximum value, it sets the RTR.IPKTCNT.OR bit to 1 and continue counting from zero. A write to this field where bit 30 is set to 1 will reset the RTR.IPKTCNT.OR bit. A write to this field where bit 30 is set to 0 has no effect.

*Table 414. 0x00000E00-0x00000E4C - RTR.MAXPLEN - Maximum packet length, ports 0-19*

31		25	24		0
	RESERVED	ML			
	0x00	0x000000			
	r	rw			

- 31: 25 RESERVED
- 24: 0 Maximum packet length (ML) - Maximum length of packets for which the corresponding port is the input port. This field is only used when the RTR.PCTRL.PL bit (RTR.PCTRLCFG.PL for port 0) is set to 1. See section 33.2.18 for details.

*Table 415. 0x00000E84-0x00000EC8 - RTR.CREDCNT - Credit counter, ports 1-18*

31		12	11	6	5	0
	RESERVED	OC		IC		
	0x00000	0		0		
	r	r		r		

- 31: 12 RESERVED
- 11: 6 Out credit counter (OC) - Number of outgoing credits. For each credit, the other end of the link is allowed to send one N-Char.
- 5: 0 In credit counter (IC) - Number of incoming credits. For each credit, the port is allowed to transmit one N-Char.

*Table 416. 0x00001004-0x000013FC - RTR.RTCOMB - Routing table, combined port mapping and address control, addresses 1-255*

31	30	29	28	27		20	19		1	0
SR	EN	PR	HD	RESERVED				PE		PD
N/R	0	N/R	N/R	0x00				N/R		N/R
rw	rw	rw	rw	r				rw		rw

- 31 Spill-if-not-ready (SR) - This bit is a double mapping of the RTR.RTACTRL.SR bit. See table 382.
- 30 Enable (EN) - This bit is a double mapping of the RTR.RTACTRL.EN bit. See table 382.
- 29 Priority (PR) - This bit is a double mapping of the RTR.RTACTRL.PR bit. See table 382.
- 28 Header deletion (HD) - This bit is a double mapping of the RTR.RTACTRL.HD bit. See table 382.
- 27: 20 RESERVED
- 19: 1 Port enable bits (PE) - This field is a double mapping of the RTR.RTPMAP.PE field. See table 381.
- 0 Packet distribution (PD) - This field is a double mapping of the RTR.RTPMAP.PD field. See table 381.

NOTE: See note for RTR.RTPMAP (table 381).

### 33.6.1 SpaceWire Plug-and-Play interface

The configuration port supports parts of the SpaceWire Plug-and-Play protocol described in [SPW-PNP]. The supported fields are listed in table 419, and explained in more detail in tables 420 through 434.

The SpaceWire Plug-and-Play protocol uses standard RMAP commands and replies with the same requirements as presented in section 33.5.1, but with the following differences:

- Protocol Identifier field of a command shall be set to 0x03.
- A command’s address fields shall contain a word address. The SpaceWire Plug-and-Play addresses are encoded as shown in table 417.
- The increment bit in the command’s instruction field shall be set to 1, otherwise a reply with Status field set to 0x0A (authorization failure) is sent.
- RMAP Read-modify-write command is replaced by a compare-and-swap operation. The command’s data fields shall contain the new data to be written, while the mask fields shall contain the value that the current data must match in order for the new data to be written. If there is a mismatch, a reply with Status field set to 0x0A (authorization failure) is sent.
- The reply packet’s Status field can contain the additional status codes described in table 418.

Table 417. SpaceWire Plug-and-Play address encoding

31	24 23	19 18	14 13	0
Application Index	Protocol Index	FieldSet ID	Field ID	

Table 418. SpaceWire Plug-and-Play status codes

Value	Description
0xF0	Unauthorized access - A write, or compare-and-swap command arrived either when the router was not configured (Device ID field = 0), or the command did not match the owner information saved in the Link Information field and Owner Address fields.
0xF1	Reserved field set - A read, write, or compare-and-swap command’s address field points to a non-existing field set.
0xF2	Read-only field - A write, or compare-and-swap command’s address points to a read-only field.
0xF3	Compare-and-swap-only-field - A write command’s address points to a compare-and-swap-only field.

Note that it is not possible to access the SpaceWire Plug-and-Play fields through the AHB slave interface, except for the fields that are double mapped into the configuration port’s address space (see section 33.6).

An access (read, write, or compare-and-swap) made either to a field outside the Device Information service, or to a field in an undefined field set within the Device Information service, will generate a reply with the Status field set to 0xF1. An access (read, write, or compare-and-swap) to an undefined or unsupported field in one of the defined field sets, within the Device Information service, is not treated as an error, and the Status field of the reply will be 0x00. Possible write-data for such an access is discarded, and possible read-data returned is always 0.

# LEON3FT Microcontroller

Please reference the [SPWPNP] for additional details to what is presented in this section.

Table 419.SpaceWire Plug-and-Play support

SpW PnP Address	Register name	Acronym	Service - Field set - Field
0x00000000	SpaceWire Plug-and-Play - Device Vendor and Product ID	RTR.PNPVEND	Device Information - Device Identification - Device Vendor and Product ID
0x00000001	SpaceWire Plug-and-Play - Version	RTR.PNPVER	Device Information - Device Identification - Version
0x00000002	SpaceWire Plug-and-Play - Device Status	RTR.PNPDEVSTS	Device Information - Device Identification - Device Status
0x00000003	SpaceWire Plug-and-Play - Active Links	RTR.PNPACTLNK	Device Information - Device Identification - Active Links
0x00000004	SpaceWire Plug-and-Play - Link Information	RTR.PNPLNKINFO	Device Information - Device Identification - Link Information
0x00000005	SpaceWire Plug-and-Play - Owner Address 0	RTR.PNPOA0	Device Information - Device Identification - Owner Address 0
0x00000006	SpaceWire Plug-and-Play - Owner Address 1	RTR.PNPOA1	Device Information - Device Identification - Owner Address 1
0x00000007	SpaceWire Plug-and-Play - Owner Address 2	RTR.PNPOA2	Device Information - Device Identification - Owner Address 2
0x00000008	SpaceWire Plug-and-Play - Device ID	RTR.PNPDEVID	Device Information - Device Identification - Device ID
0x00000009	SpaceWire Plug-and-Play - Unit Vendor and Product ID	RTR.PNPUVEND	Device Information - Device Identification - Unit Vendor and Product ID
0x0000000A	SpaceWire Plug-and-Play - Unit Serial Number	RTR.PNPUSN	Device Information - Device Identification - Unit Serial Number
0x00004000	SpaceWire Plug-and-Play - Vendor String Length	RTR.PNPVSTRL	Device Information - Vendor / Product String - Vendor String Length
0x00006000	SpaceWire Plug-and-Play - Product String Length	RTR.PNPPSTRL	Device Information - Vendor / Product String - Product String Length
0x00008000	SpaceWire Plug-and-Play - Protocol Count	RTR.PNPPCNT	Device Information - Protocol Support - Protocol Count
0x0000C000	SpaceWire Plug-and-Play - Application Count	RTR.PNPACNT	Device Information - Application Support- Application Count

Table 420. 0x00000000 - RTR.PNPVEND - SpaceWire Plug-and-Play - Device Vendor and Product ID

31	VEND	16 15	PROD	0
	0x0003		0x0716	
	r		r	

31: 16 Vendor ID (VEND) - SpaceWire vendor ID assigned to Frontgrade Gaisler. Constant value of 0x0003.

15: 0 Product ID (PROD) - Product ID assigned to GR716 products. Constant value of 0x0716

# LEON3FT Microcontroller

Table 421. 0x00000001 - RTR.PNPVER - SpaceWire Plug-and-Play - Version

31	24	23	16	15	8	7	0	
MAJOR			MINOR			PATCH		RESERVED
0x01			0x03			0x00		0x00
r			r			r		r

- 31: 24 Major version number (MAJOR) - Constant value of 0x01.
- 23: 16 Minor version number (MINOR) - Constant value of 0x03.
- 15: 8 Patch / Build number (PATCH) - Constant value of 0x00.
- 7: 0 RESERVED

Table 422. 0x00000002 - RTR.PNPDEVSTS - SpaceWire Plug-and-Play - Device Status

31	8	7	0
RESERVED		STATUS	
0x000000		0x00	
r		r	

- 31: 8 RESERVED
- 7: 0 Device status (STATUS) - Constant value of 0x00.

Table 423. 0x00000003 - RTR.PNPACTLNK - SpaceWire Plug-and-Play - Active Links

31	20	19	1	0
RESERVED		ACTIVE		R
0x000		0x00000		0
r		r		r

- 31: 20 RESERVED
- 19: 1 Link active (ACTIVE) - If set to 1, the port with the same number as the bit index is running. If set to 0, the port is not running. For the SpaceWire ports (ports 1-18), the corresponding bit will be set to 1 if the link interface is in run-state and the port is not disabled through the Port Control register (RTR.PCTRL.DI = 0). For the SIST port (port 19), the bit is set to 1 if RTR.PCTRL.DI = 0.
- 0 RESERVED

Table 424. 0x00000004 - RTR.PNPLNKINFO -SpaceWire Plug-and-Play - Link Information

31	24	23	22	21	20	16	15	13	12	8	7	6	5	4	0
OLA			OAL	R	OL	RES	RL	T	U	R	LC				
0x00			0x0	0	0x0	0x0	0x0	1	0	0	0x13				
r			r	r	r	r	r	r	r	r	r				

- 31: 24 Owner logical address (OLA) - Shows the value of the Initiator Logical Address field from the last successful compare-and-swap command that set the Device ID field.
- 23: 22 Owner address length (OAL) - Shows how many of the three Owner Address fields that contain valid data.
- 21 RESERVED
- 20: 16 Owner link (OL) - Shows the number of the port which was used for the last successful operation to set the value of the Device ID field.
- 15: 13 RESERVED

# LEON3FT Microcontroller

*Table 424. 0x00000004 - RTR.PNPLNKINFO -SpaceWire Plug-and-Play - Link Information*

- 12: 8 Return link (RL) - Shows the number of the port through which the reply to the current read command will be transmitted.
- 7 Device type (T) - Constant value of 1, indicating that this device is a router.
- 6 Unit information (U) - Indicates if the unit identification information (Unit Vendor and Product ID field, and Unit Serial Number field) are valid. 0 = invalid, 1 = valid. This bit will be 0 after reset / power-up. Once the Unit Vendor and Product ID field has been written with a non-zero value, this bit will be set to 1.
- 5 RESERVED
- 4: 0 Link count (LC) - Shows the number of router ports. Constant value of 0x13.

*Table 425. 0x00000005 - RTR.PNPOA0 - SpaceWire Plug-and-Play - Owner Address 0*

31	0
RA	
0x00000000	
r	

- 31: 0 Reply address (RA) - Shows byte 0-3 of the Reply Address from the last successful compare-and-swap command that set to the Device ID field. If there was no Reply Address, then this field is zero.

*Table 426. 0x00000006 - RTR.PNPOA1 - SpaceWire Plug-and-Play - Owner Address 1*

31	0
RA	
0x00000000	
r	

- 31: 0 Reply address (RA) - Shows byte 4-7 of the Reply Address from the last successful compare-and-swap command that set to the Device ID field. If the Reply Address was four bytes or less, then this field is zero.

# LEON3FT Microcontroller

Table 427. 0x00000007 - RTR.PNPOA2 - SpaceWire Plug-and-Play - Owner Address 2

31	RA	0
	0x00000000	
	r	

31: 0 Reply address (RA) - Shows byte 8-11 of the Reply Address from the last successful compare-and-swap command that set to the Device ID field. If the Reply Address was eight bytes or less, then this field is zero.

Table 428. 0x00000008 - RTR.PNPDEVID - SpaceWire Plug-and-Play - Device ID

31	DID	0
	0x00000000	
	cas	

31: 0 Device ID (DID) - Shows the device identifier. After reset / power-up, or when this field is written to zero, the router is not considered to have an owner. The same applies to the case when the port indicated by the OL bits in the Link Information field is either disconnected, or disabled by setting the RTR.PCTRL.DI bit to 1. This field is only writable through a compare-and-swap operation.

Table 429. 0x00000009 - RTR.PNPUVEND - SpaceWire Plug-and-Play - Unit Vendor and Product ID

31	16 15	0
VEND	PROD	
0x0000	0x0000	
r	r	

31: 16 Unit vendor ID (VEND) - Shows the unit vendor identifier. This field is read-only through the SpaceWire Plug-and-Play protocol, however it is writable through RMAP and AHB (see section 33.6). When this field, or the PROD field, is written with a non-zero value, the U bit in the Link Information field is set to 1.

15: 0 Unit product ID (VEND) - Shows the unit product identifier. This field is read-only through the SpaceWire Plug-and-Play protocol, however it is writable through RMAP and AHB (see section 33.6). When this field, or the VEND field, is written with a non-zero value, the U bit in the Link Information field is set to 1.

Table 430. 0x0000000A - RTR.PNPUSN - SpaceWire Plug-and-Play - Unit Serial Number

31	USN	0
	0x00000000	
	r	

31: 0 Unit serial number (USN) - Shows the unit serial number. This field is read-only through the SpaceWire Plug-and-Play protocol, however it is writable through RMAP and AHB (see section 33.6).

# LEON3FT Microcontroller

*Table 431. 0x00004000 - RTR.PNPVSTRL - SpaceWire Plug-and-Play - Vendor String Length*

31	15 14	0
RESERVED	LEN	
0x00000	0x0000	
r	r	

31: 15 RESERVED

14: 0 Vendor string length (LEN) - Constant value of 0, indicating that no vendor string is present.

*Table 432. 0x00006000 - RTR.PNPPSTRL - SpaceWire Plug-and-Play - Product String Length*

31	15 14	0
RESERVED	LEN	
0x00000	0x0000	
r	r	

31: 15 RESERVED

14: 0 Product string length (LEN) - Constant value of 0, indicating that no product string is present.

*Table 433. 0x00008000 - RTR.PNPPCNT - SpaceWire Plug-and-Play - Protocol Count*

31	5 4	0
RESERVED	PC	
0x0000000	0x00	
r	r	

31: 5 RESERVED

4: 0 Protocol count (PC) - Constant value of 0, indicating that no protocols can be managed by using SpaceWire Plug-and-Play.

*Table 434. 0x0000C000 - RTR.PNPACNT - SpaceWire Plug-and-Play - Application Count*

31	8 7	0
RESERVED	AC	
0x0000000	0x00	
r	r	

31: 8 RESERVED

7: 0 Application count (AC) - Constant value of 0, indicating that no applications can be managed by using SpaceWire Plug-and-Play.

# LEON3FT Microcontroller

## 34 SpaceWire - Time Distribution Protocol

### 34.1 Overview

This core provides basic time keeping functions such as Elapsed Time counter according to the CCSDS Unsegmented Code specification. It provides support for setting and sampling the Elapsed Time counter. It also includes a frequency synthesizer with which a binary frequency is generated to drive the Elapsed Time counter. This interface implements the SpaceWire - Time Distribution Protocol (TDP). The protocol provides capability to transfer time values and synchronise them between onboard users of SpaceWire network. The time values are transferred as CCSDS Time Codes and synchronisation is performed through SpaceWire Time-Codes. The core also provides datation services. The AMBA APB bus is used for configuration, control and status handling.

### 34.2 Protocol

The initiator and target maintain their own time locally. The Time Distribution Protocol provides the means for transferring time of initiator to targets and for providing a synchronization point in time. The time is transferred by means of an RMAP write command carrying a CCSDS Time Code (time message). The synchronization event is signaled by means of transferring a SpaceWire Time-Code. The transfer of the SpaceWire Time-Code is synchronized with time maintained by the initiator. To distinguish which SpaceWire Time-Code is to be used for synchronization, the value of SpaceWire Time-Code is transferred from initiator to target by means of an RMAP write command prior to actual transmission of SpaceWire Time-Code itself. When there is more than one target the CCSDS Time Code need to be transferred to each individual target separately [SPWCUC].

### 34.3 Functionality

The block diagram below shows how the controller is connected to the system.

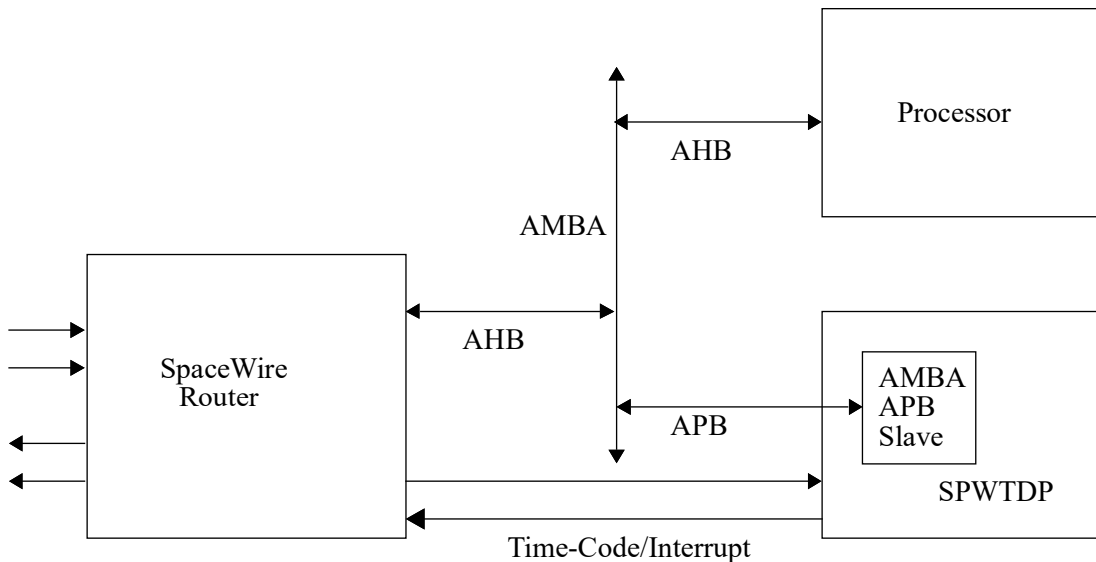


Figure 65. Block diagram

The foreseen usage of this core is to distribute and synchronise time between an initiator SPWTDP core and one or more target SPWTDP (slave) cores using the SpaceWire interface for communication between them.

The system can act as initiator (time master) and target being able to send and receive SpaceWire Time-Codes. The initiator requires SpaceWire link interface implements an RMAP initiator (in



# LEON3FT Microcontroller

GR716B the SpW router AMBA ports with the help of software can act as RMAP initiator). The Target requires SpaceWire link interface implements an RMAP target (in GR716B the SpW router AMBA ports can handle RMAP packets in HW as a target). The SPWTDP component is a part of this system providing SpaceWire Time-Codes, CCSDS Time Codes, datation, time-stamping of distributed interrupts, support for transmission of CCSDS Time Codes through RMAP and support for latency measurement and correction. In this implementation the CCSDS Time Codes carried between the SpaceWire network is based on CCSDS Unsegmented Code format (CUC) which is explained below [CCSDS]. The table below shows an example Preamble Field (P-Field) which corresponds to 32 bits of coarse time and 24 bits of fine time.

### 34.3.1 CCSDS Unsegmented Code: Preamble Field (P-Field)

Table 435. CCSDS Unsegmented Code P-Field definition

Bit	Value	Interpretation
0	“0”	Extension flag, P-Field extended with 2nd octet
1-3	“010”	Agency-defined epoch (Level 2)
4 - 5	“11”	(number of octets of coarse time) + 1
6 - 7	“11”	(number of octets of fine time)
8	“0”	Extension flag, P-Field not extended with 3rd octet
9-10	“00”	Number of additional octets of the coarse time.
11-13	“000”	Number of additional octets of the fine time.
14-15		RESERVED

### 34.3.2 CCSDS Unsegmented Code: Time Field (T-Field)

For the unsegmented binary time codes described herein, the T-Field consists of a selected number of contiguous time elements, each element being one octet in length. An element represents the state of 8 consecutive bits of a binary counter, cascaded with adjacent counters, which rolls over at a modulo of 256.

Table 436. Example CCSDS Unsegmented Code T-Field with 32 bit coarse and 24 bit fine time

CCSDS Unsegmented Code														
Preamble	Time Field													
Field	Coarse time						Fine time							
-	2 <sup>31</sup>	2 <sup>24</sup>	2 <sup>23</sup>	2 <sup>16</sup>	2 <sup>15</sup>	2 <sup>8</sup>	2 <sup>7</sup>	2 <sup>0</sup>	2 <sup>-1</sup>	2 <sup>-8</sup>	2 <sup>-9</sup>	2 <sup>-15</sup>	2 <sup>-16</sup>	2 <sup>-24</sup>
0:15	0						31	32						55

The basic time unit is the second. The T-Field coarse time (seconds) can be maximum 56 bits and minimum 8 bits. The T-Field fine time (sub seconds) can be maximum 80 bits and minimum of 0 bits.

The number of bits representing coarse and fine time implemented in this core can be obtained by reading the DPF bits of Datation Preamble Field register.

The coarse time code elements are a count of the number of seconds elapsed from the initial time value. This code is not UTC-based and leap second corrections do not apply according to CCSDS.

### 34.3.3 Time generation

The core consist of time generator which is the source for time in this system. The core may act as initiator or a target but both have their respective time generator. The Elapsed Time (ET) counter is implemented complying with the CUC T-Field. The number of bits representing coarse and fine time

# LEON3FT Microcontroller

of a ET counter implemented in a design can be obtained by reading the DPF bits of Datation Preamble Field register.

The ET counter can be incremented either using an internal frequency synthesizer or by using an external enable signal. The External ET Increment Enable bit in Configuration 0 register must be enabled if external inputs are to be used.

Increment ET using internal frequency synthesizer:

The counter is incremented on the system clock only when enabled by the frequency synthesizer. The binary frequency required to determine the counter increment is derived from the system clock using a frequency synthesizer (FS). The frequency synthesizer is incremented with a pre-calculated increment value, which matches the available system clock frequency. The frequency synthesizer generates a tick every time it wraps around, which makes the ET time counter to step forward with the pre-calculated increment value. The output of frequency synthesizer is used for enabling the increment of ET counter. The increment rate of the ET counter and frequency synthesizer counter should be set according to the system clock frequency. The ET counter increment rate is set by providing values to ETINC bits in Configuration 2 register and frequency synthesizer counter is set by providing values to FSINC bits in Configuration 1 register. The following table specifies some example ETINC and FSINC values for some frequencies. The below values are also obtained for Coarse time width 32, Fine time width 24 and Frequency synthesizer width of 30. To calculate for other frequencies and configuration refer the spreadsheet [SPWTDP].

Table 437. Example values of ETINC and FSINC for corresponding frequencies

Frequency MHz	ETINC	FSINC
100	0	180143985
50	0	360287970
33333333	2	135107990

Increment ET using external input:

The EP register in Configuration 0 specify whether to increment the ET counter based on rising or falling edge of the external enable signal. Also the ETINC bits in Configuration 2 register specify from which bit the ET counter must increment.

The following section describes the cores capabilities if it configured as initiator or target.

### 34.3.4 Initiator

An initiator is a SpaceWire node distributing CCSDS Time Codes and SpaceWire Time-Codes. It is also an RMAP initiator, capable of transmitting RMAP commands and receiving RMAP replies. There is only one active initiator in a SpaceWire network during a mission phase.

The initiator performs the following tasks

- Transmission of SpaceWire Time-Codes. The SpaceWire Time-Codes are provided by this component and transmission of those codes to targets should be performed by a SpaceWire interface. (in GR716B the SpW router SpW ports perform the transmission of time codes).
- Transmission of CCSDS Time Codes through RMAP. The SPWTDP core provides the required CCSDS Time Codes, the formation of RMAP packets should be done in SW and the RMAP packets can be transmitted using the SpW router AMBA port.
- Datation, time-stamping and latency measurement

# LEON3FT Microcontroller

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## 34.3.5 Target

A target is a SpaceWire node receiving CCSDS Time Codes and SpaceWire Time-Codes. A target is also an RMAP target, capable of receiving RMAP commands and transmitting RMAP replies. There can be one or more targets in a SpaceWire network.

The target performs the following tasks

- Reception of SpaceWire Time-Codes. The SpaceWire Time-Codes sent from initiator are received by SpaceWire interface (in GR716B SpW router SpW ports receives time codes) and provided to this component in target.
- Reception of CCSDS Time Codes through RMAP. In GR716B, the RMAP packets are received by the SpW router AMBA ports and handles by its RMAP target.
- Qualification of received time messages (CCSDS Time Codes) using SpaceWire Time-Codes
- Initialization and Synchronisation of received CCSDS Time Codes with Elapsed Time counter available in this component
- Datation, time-stamping and latency correction

## 34.3.6 Configuring initiator and target

The core is interfaced via an AMBA Advanced Peripheral Bus (APB) slave interface, providing a register view that is compatible with the Time Distribution Protocol (TDP). The core must be configured according to the requirement either as initiator or target.

- Initializing initiator

The initiator transmits the SpaceWire Time-Codes out of the core only when the Transmit Enable TE bit in Configuration 0 register is enabled. The ET counter in initiator can be initialized (to provide any initial value). Initialization is done by writing a time value into the Command Elapsed Time registers available in the command field, the NC bit in the Control register of command field should be enabled to initialize the time value stored in the Command Elapsed Time registers to be the local time (Transmit Enable TE bit in Configuration 0 register must be enabled). The NC bit in the Control register will disable itself when the time is initialized. The INSYNC bit in Status 0 register will enable when initialization is performed. The MAPPING bits in Configuration 0 register determines the interval between SpaceWire Time-Code transmissions which is explained in detail in the section below.

The target time must be configured with time values from the initiator. The targets register space must be configured and controlled through RMAP by an initiator to achieve time synchronisation. The target time synchronisation is explained in detail under the section initialization and synchronisation of target through RMAP.

## 34.3.7 SpaceWire Time-Code

SpaceWire Time-Codes are continuously transmitted from an initiator node (time master) to all slave nodes. The transmission of the SpaceWire Time-Code is synchronized with the ET counter in the initiator node. The six bits of the Time-Code time information correspond to six bits of the local ET counter (MAPPING bits in Configuration 0 register determines its exact mapping and interval between SpaceWire Time-Code transmissions). Value of 0b00000 for MAPPING bits in Configuration 0 register will send SpaceWire Time-Code at every Second. When the value is 0b00001 SpaceWire Time-Codes are sent at every 0.5 Seconds interval and so on (maximum value of MAPPING can be 0b11111 but this value cannot be more than the number of bits implemented as fine time). The ET bits with lower weights than the size bits mapped to Time Codes time information bits are all zero at time of SpaceWire Time-Codes transmission. The Table below shows an example Local ET



- Time qualification in target

In target, the Command field will contain the time message when it is written by the initiator through RMAP. When the SPWTC of Control register in Command field matches with a received SpaceWire Time-Code then initialization or synchronization will occur (according to NC bit and IS bit in the Control register) to the local ET counter of the target SPWTDP component. When the local ET counter is initialized or synchronized the NC bit in the control register will disable itself. The INSYNC bit in Status 0 register will enable when initialization is performed specifying the target is initialized. Initialization completely writes time message values into the implemented local Elapsed time counter and synchronisation verifies whether the time message Command Elapsed Time and local Elapsed Time counter matches till the mapped SpaceWire Time-Code level (with a tolerance of previous value) and only modifies the local Elapsed Time if their is a mismatch. Since the GR716 target is not implemented with a jitter and mitigation unit the synchronisation forces the target time (ET counter) with the time message received.

For example, the initiator can create time message exactly at 0x00000001 coarse time and 0x040000 fine time (32 bit coarse time and 24 bit fine time, mapping value of 6 i.e. 64 SpaceWire Time-Codes per second, time message is generated at 0b000001 SpaceWire Time-Code), the value in the time message to be sent to the target can be coarse time 0x00000002 and 0x040000 fine time, (32 bit coarse time and 24 bit fine time, mapping value of 6, time message is qualified at the next reception of 0b000001 SpaceWire Time-Code, i.e. after a second). Both SPWTC in Control registers available in the initiator and target can be 0b000001 for this example. The time is synchronized after a second in this example. Depending on the frequency of SpaceWire Time-Codes and data link rate several different combination of ways to achieve time synchronisation is possible.

### 34.3.9 Latency measurement using Time-Stamps

The incoming and outgoing SpaceWire Distributed Interrupts are time stamped in initiator and target. The initiator calculates latency based on these time stamp values. The time stamped values in target are accessed from initiator through RMAP. The Latency Enable LE bit in Configuration 0 register must be enabled between the two nodes in the SpaceWire network for which the latency is to be calculated. The core supports 32 distributed interrupts and acknowledgement (Interrupt and acknowledgement numbers 0 to 31). The distributed interrupt transmission from initiator (which is the origin for latency calculation) is controlled by a mask register STM available in Configuration 3 register and SpaceWire time code register TSTC available in Time-Stamp SpaceWire Time-Code and Preamble Field Tx register, these registers specifies how often and at which time code distributed interrupt is transmitted and time stamping is performed.

The time stamping can be performed in two methods (only Interrupts or Interrupts and Acknowledgement), the DI bit in Configuration 3 register of SPWTDP component in target should be configured to specify which type of method is used. If only distributed interrupts (no acknowledgement) are used then DI bit should be 0. The transmitted and received distributed interrupts INTX and INRX in the Configuration 0 registers of both initiator and target must be configured with the interrupt number which will be used for the latency measurement. For example if the INTX in initiator Configuration 0 is configured with 0b00100 then the target INRX should be configured with the same value. Similarly if the INTX in target Configuration 0 is configured to be 0b00101 then the initiator INRX should be configured with the same value. Initially initiator sends a distributed interrupt when the conditions are matched (STM and TSTC registers match) and when the target received this distributed interrupt it will send another interrupt which will be received by the initiator. At each end transmission and reception is time stamped (current local time is stored in Time Stamp registers) and interrupt transmitted is INTX and received interrupt is checked whether it received INRX.

If both distributed interrupts and acknowledgement method is to be used then DI bit should be 1. The transmitted and received distributed interrupts INTX and INRX in the Configuration 0 registers of both initiator and target can have the same interrupt number (the acknowledgement number for a particular interrupt will be same as interrupt number). Similar to the previous method at each end transmission and reception is time stamped which will be used for latency calculations.

# LEON3FT Microcontroller

The Latency calculation can be started in initiator based on DIR (distributed interrupt received) interrupt available in Interrupt Status register (the interrupt should be enabled in the Interrupt Enable register). The latency is calculated from the time stamp registers based on the equation explained below

$$\text{Latency} = ((\text{initiator time stamp Rx} - \text{initiator time stamp Tx}) - (\text{target time stamp Tx} - \text{target time stamp Rx})) / 2$$

By calculating the Latency value repeatedly (at least for about 128 times, more number of times provides increased accuracy) and taking an average of it will provide the final latency value. The initiator should transfer the latency correction information to the Latency Field registers in the target by means of RMAP transfer. When the latency values are written it will be adjusted to local time in the target and the LC bit in Status 0 register is enabled (set to '1'), this status register can be disabled by writing '1' into the corresponding field.

### 34.3.10 External Datation

The core provides external datation services, there are four external datation services implemented which can time stamp the Elapsed Time counter when the conditions for a respective event (time stamping) occurs. The event on which time stamp must occur is configurable individually (using the respective mask registers EDMx and also a dedicated mask bit is available for each of the input events) for all the external datation services.

Each of the four external datation services implemented has its own mask EDMx, status EDS and time EDxETx registers. (here the x suffix represent 0, 1, 2 and 3 respect to individual registers available)

All the external datation services share the same event inputs (32 inputs).

The table below describes the inputs connected.

*Table 439. Input Events on which time stamp occurs.*

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq	LS	irq	irq	irq	irq	irq	irq	irq	irq	irq	irq		
31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11		9	8	7	6	5	4	3	2	1	0		
		31: 11																															
		10																															
		9: 0																															

Any condition match for a particular external datation service will clear its respective mask register EDMx (clears all the mask bits and must be set again in order to achieve an another time stamp). The condition match can also invert GPIO lines. The condition match on external datation service 0 can invert the GPIO line 7, similarly for services 1, 2 and 3 the respective GPIO lines are 8, 9 and 10. When the corresponding GPIO Pulse register is enabled and external datation event occurs then the respective GPIO line is inverted. The EDS bit in Status Register 0 will go high when the condition matches and cleared when the latched elapsed time is read. The purpose of this status register is to ensure that all the implemented coarse and fine time are read. Reading the lowest implemented fine time makes the status register to go low.

### 34.3.11 Set Elapsed Time using external input

The ET counter can be set using an external enable signal (configurable rising or falling edge, see register SP in Configuration 0 register). To set the ET counter the SE bit in configuration register must be enabled, the value to be loaded into the ET counter must be written into the Command Elapsed Time registers. The ARM bit field in the Status 0 register will set itself to '1' when the first Command Elapsed Time register is written. After the occurrence of the external enable signal the value will be loaded into the ET counter and the ARM bit field in the Status 0 register will set itself to '0'. An interrupt can also be generated when the ET counter is loaded, the corresponding interrupt (Set ET External Interrupt Enable) must be enabled.

### 34.3.12 Synchronisation of target using SpaceWire Time-Codes

It is possible to synchronise the target only using SpaceWire Time-Codes. A master sending SpaceWire Time-Codes (using its Elapsed time counter) at regular interval can synchronise the Elapsed time in the target. The frequency of Time-code transmission in the master and the frequency of (when to expect a) Time-code in the target must match, this can be achieved by setting the Mapping fields in the Configuration 0 register. The incoming SpaceWire Time-Codes and the Time-code position mapped in the target Elapsed Time is compared, if they match the bits available after the compared bits are made zero, if the local time map is less than one (External Time-code arrived early) then the bits available after the compared bits are made zero and the other part (including the mapped part) is incremented by one. If the above two cases occurred then the target time is in sync with the master time and the Insync bit in Status 0 register is enabled. If the incoming Time-code is in out of order (Non consecutive) then the synchronisation is stopped, the Insync bit in Status 0 register is disabled (but the local time keeps running) and an interrupt is generated if corresponding interrupt (Non consecutive SpaceWire Time-code Interrupt) bit is enabled.

# LEON3FT Microcontroller

## 34.4 Registers

The core is programmed through registers mapped into AMBA APB address space.

Table 440. Registers

APB address offset	Register
0x000-0x00F	Configuration Field
0x000	Configuration 0
0x004	Configuration 1
0x008	Configuration 2
0x00C	Configuration 3
0x010 - 0x01F	Status Field
0x010	Status 0
0x014	Status 1
0x018	RESERVED
0x01C	RESERVED
0x020 - 0x03F	Command Field
0x020	Control
0x024	Command Elapsed Time 0
0x028	Command Elapsed Time 1
0x02C	Command Elapsed Time 2
0x030	Command Elapsed Time 3
0x034	Command Elapsed Time 4
0x038	RESERVED
0x03C	RESERVED
0x040 - 0x05F	Datation Field
0x040 - 0x05F	Datation Field
0x040	Datation Preamble Field
0x044	Datation Elapsed Time 0
0x048	Datation Elapsed Time 1
0x04C	RESERVED
0x050	RESERVED
0x054	RESERVED
0x058	RESERVED
0x05C	RESERVED
0x060 - 0x09F	Time-Stamp Field
0x060	Time-Stamp Preamble Field Rx
0x064	Time-Stamp Elapsed Time 0 Rx
0x068	Time-Stamp Elapsed Time 1 Rx
0x06C	RESERVED
0x070	RESERVED
0x074	RESERVED
0x078	RESERVED
0x07C	RESERVED
0x080	Time-Stamp SpaceWire Time-Code and Preamble Field Tx
0x084	Time-Stamp Elapsed Time 0 Tx



# LEON3FT Microcontroller

0x088	Time-Stamp Elapsed Time 1 Tx
0x08C	RESERVED
0x090	RESERVED
0x094	RESERVED
0x098	RESERVED
0x09C	RESERVED
0x0A0-0x0BF	Latency Field
0x0A0	Latency Preamble Field
0x0A4	Latency Elapsed Time 0
0x0A8	Latency Elapsed Time 1
0x0AC	RESERVED
0x0B0	RESERVED
0x0B4	RESERVED
0x0B8	RESERVED
0x0BC	RESERVED
0x0C0	Interrupt Enable
0x0C4	Interrupt Status
0x0C8	Delay Count
0x0CC	Disable Sync
0x0D0-0x0FF	RESERVED
0x100-0x18F	External Datation Field
0x100	External Datation 0 Mask
0x104	External Datation 1 Mask
0x108	External Datation 2 Mask
0x10C	External Datation 3 Mask
0x110-0x12F	External Datation 0 Time
0x110	External Datation 0 Preamble Field
0x114	External Datation 0 Elapsed Time 0
0x118	External Datation 0 Elapsed Time 1
0x11C	RESERVED
0x120	RESERVED
0x124	RESERVED
0x128	RESERVED
0x12C	RESERVED
0x130-0x14F	External Datation 1 Time
0x150-0x16F	External Datation 2 Time
0x170-0x18F	External Datation 3 Time
0x190-0x1FF	RESERVED

# LEON3FT Microcontroller

Table 441.0x000 - CONF0 - Configuration 0

31	25	24	23	21	20	19	18	17	16	15	14	13	12	8	7	6	5	4	3	2	1	0	
RESERVED	R	RES	ST	EP	ET	SP	SE	LE	AE	RES	MAPPING				TD	MU	SEL	ME	RE	TE	RS		
0	0	0	0	1	0	1	0	0	0	0	0b00110				0	0	0	0	0	0	0	0	0
r	rw	r	rw	rw	rw	rw	rw	rw	rw	rw	r	rw				rw	rw	rw	rw	rw	rw	rw	rw

- 31: 25 RESERVED
- 24 RESERVED
- 23: 22 RESERVED
- 21: Synchronisation using SpaceWire Time-Code Enable (only for target).
- 20: External ET Increment Polarity (EP) - To select the rising or falling edge of the external enable signal to increment the Elapsed time. Value '1' Rising edge. Value '0' Falling edge.
- 19: External ET Increment Enable.(ET) - To increment the Elapsed Time based on external signal. When disabled the internal frequency synthesizer is used to increment the Elapsed Time counter.
- 18: Set ET External Polarity (SP) - To select the rising or falling edge of the external enable signal to load the Elapsed Time with the contents of the command field register.
- 17: Set ET External Enable (SE) - Based on the external enable signal load the Elapsed Time with the contents of the command field register.
- 16: Latency Enable (LE) - To calculate latency between an initiator and target this bit must be enabled in both of them.
- 15: AMBA Interrupt Enable (AE) - The interrupts (explained in interrupt registers) in this core will generate an AMBA interrupt only when this bit is enabled.
- 14 13 RESERVED
- 12: 8 Mapping (MAP) - Defines mapping of SpaceWire Time-Codes versus CCSDS Time-code.  
  - Value 0b00000 will send SpaceWire Time-Codes every Second,
  - Value 0b00001 will send SpaceWire Time-Codes every 0.5 Second,
  - Value 0b00010 will send SpaceWire Time-Codes every 0.25 Second,
  - Value 0b00011 will send SpaceWire Time-Codes every 0.125 Second
 The maximum value it can take is 0b11000.
- 7: Enable TDP (TD) - Enable to indicate that the TDP provides SpaceWire Time-codes and Distributed interrupts to the SpW router. Internally this signal is connected to the SpW router auxiliary time input enable signal which enables the routers auxiliary interface.
- 6: RESERVED
- 5: 4 Select (SEL) - Select for SpaceWire Time-Codes and Distributed Interrupt transmission and reception, one of 0 through 3, (must always be 0b00 in this implementation).
- 3: Mitigation Enable (ME) - (not usable in this implementation).
- 2: Receiver Enable (RE) - Enabling this will make the core to act as target.
- 1 Transmit Enable (TE) - Enabling this will make the core to act as initiator.  
 The core can act only as an initiator or target, both TE and RE cannot be enabled at the same time.
- 0 Reset (RS) - Reset core. Makes complete reset when enabled, self clears itself (to disable).

Table 442. 0x004 - CONF 1 - Configuration 1

31	30	29	0
-			FSINC
0			0
r			rw

# LEON3FT Microcontroller

Table 442. 0x004 - CONF 1 - Configuration 1

31: 30	RESERVED
29: 0	Frequency synthesizer (FSINC) - Increment value of the Frequency Synthesizer which is added to the counter every system clock cycle. It defines the frequency of the synthesized reference time. Refer the spreadsheet [SPWTDP]

Table 443. 0x008 - CONF 2 - Configuration 2

31		8	7	0
	CV			ETINC
	0			0
	rw			rw

31: 8	Compensation Value (CV) - (not usable in this implementation)
7: 0	Elapsed Time Increment (ETINC) - Value of the Elapsed Time counter is to be incremented each time when the Frequency Synthesizer wraps around. Refer the spreadsheet [SPWTDP]

Table 444. 0x00C - CONF3 - Configuration 3

31		22	21		16	15	14	13	12	11	10	9		5	4	0
	-		STM		-		DI64R	DI64T	DI64	DI		INRX			INTX	
	0		0		0		0	0	0	0		0			0	
	r		rw		r		rw	rw	rw	rw		rw			rw	

31: 22	RESERVED
21: 16	SpaceWire Time-Code Mask (STM) - Mask For TSTC register available at Time-Stamp SpaceWire Time-Code and Preamble Field Tx register. Value all bits zero will send Distributed interrupts at all SpaceWire Time-Codes irrespective of any values in TSTC register. Value all ones will send Distributed interrupts at complete match of SpaceWire Time-Code with TSTC register. (only for initiator)
15: 14	RESERVED
13:	DI64R - The MSb for received Distributed Interrupt when interrupt numbers 32 to 63 is used. Possible only for DI = '0' (only interrupt mode) and DI64 is enabled.
12:	DI64T - The MSb for transmitted Distributed Interrupt when interrupt numbers 32 to 63 is used. Possible only for DI = '0' (only interrupt mode) and DI64 is enabled.
11:	Enable Distributed Interrupts 64 (DI64) - when set all 64 Distributed interrupt numbers can be used for latency calculation. Possible only for DI = '0' (only interrupt mode).
10:	Distributed Interrupt (DI) - Distributed Interrupt method, when set interrupt and acknowledge mode else only interrupt mode. (only for target)
9: 5	Interrupt Received (INRX) - The distributed interrupt number received by initiator or target.
4: 0	Interrupt Transmitted (INTX) - The distributed interrupt number transmitted by initiator or target.

Table 445. 0x010 - STAT 0 - Status Register 0

31	30	28	27		24	23	22		16	15	14	13		8	7		4	3		2		1	0
MA	-		EDS		-		FW		-		CW		-		AR	M		LC		TCQ		INSYNC	
0	0		0		0		0		0		0		0		0		0		0		0		0
r	r		r		r		r		r		r		r		r		wc		r		r		r

31:	Mitigation available (MA) - Mitigation unit available 0 Drift and Jitter mitigation unit not available.
30: 28	RESERVED

# LEON3FT Microcontroller

Table 445. 0x010 - STAT 0 - Status Register 0

27: 24	External Datation Status (EDS) - When conditions matched for external datation this bit will go high. This bit will go low when all the implemented time values are read.
	24: External Datation 0 Status bit
	25: External Datation 1 Status bit
	26: External Datation 2 Status bit
	27: External Datation 3 Status bit
23	RESERVED
22: 16	Fine Width (FW) - Fine width of command CCSDS Time Code received. Calculated from Preamble field of Command Register.
15: 14	RESERVED
13: 8	Coarse Width (CW) Coarse width of command CCSDS Time Code received, calculated from Preamble field of Command Register.
7: 4	RESERVED
3:	Armed (ARM) - This field is enabled when the command field register is written with the value to be loaded into the Elapsed time. The Set ET External Enable SE bit in the Configuration 1 must be enabled. When an external enable signal occurred and the command field register contents are loaded into the Elapsed time then this bit will get disabled.
2	Latency Corrected (LC) - Goes high when the latency value is written into latency registers in target (only for target).
1	Time Message Qualified (TCQ)- Time message is qualified by SpaceWire Time-Codes.
0	In Sync (INSYNC) - In Synchronization at Time code level, enabled when time values are Initialized or Synchronized.

Table 446. 0x014 - STAT 1 - Status Register 1

31	30	29	0
-			IV
0			0
r			r

31: 30	RESERVED
29: 0	Increment Variation (IV) - (not usable in this implementation)

Table 447. 0x020 - CTRL - Control

31	30	29	24	23	16	15	0
NC	IS	-	SPWTC		CPF		
0	0	0	0		0		
rw	rw	r	rw		rw		

31:	New Command (NC) - New command is set to provide a new time value.
30:	Init or Sync (IS) - '1' Initialization of received time message 0' Synchronisation of received time message (only for target).
29: 24	RESERVED
23: 16	Spacewire Time-code (SPWTC) - Spacewire Time-code value used for initialization and synchronization.  In initiator the SpaceWire Time-Codes generated internally using the local ET counter matches this register a Time Message TM interrupt will be generated which is used to send Time message over the SpaceWire network.  In target this register should match the received SpaceWire Time-code for time qualification.
15: 0	Command Preamble Field (CPF) - The number of coarse and fine time available in Command Elapsed Time registers should be mentioned in this field. Based on this preamble field the target will initialize or synchronise the local ET counter (only for target).

# LEON3FT Microcontroller

Table 448. 0x024 - CET0 - Command Elapsed Time 0

31	0
CET0	
0	
rw	

31: 0 Command Elapsed Time 0 (CET0) - Initialize or Synchronise local ET counter value (0 to 31).

Table 449. 0x028 - CET1 - Command Elapsed Time 1

31	0
CET1	
0	
rw	

31: 0 Command Elapsed Time 1 (CET1) - Initialize or Synchronise local ET counter value (32 to 63).

Table 450. 0x02C - CET2 - Command Elapsed Time 2

31	0
CET2	
0	
rw	

31: 0 Command Elapsed Time 2 (CET2) - Initialize or Synchronise local ET counter value (64 to 95).

Table 451. 0x030 - CET3 - Command Elapsed Time 3

31	0
CET3	
0	
rw	

31: 0 Command Elapsed Time 3 (CET3) - Initialize or Synchronise local ET counter value (96 to 127).

Table 452. 0x034 - CET4 - Command Elapsed Time 4

31	24 23	0
CET4	RESERVED	
0	0	
rw	r	

31: 24 Command Elapsed Time 4 (CET4) - Initialize or Synchronise local ET counter value (128 to 135).  
23: 0 RESERVED

Table 453. 0x040 - DPF - Datation Preamble Field

31	16 15	0
RESERVED		DPF
0		0x2f00
r		r

31: 16 RESERVED  
15: 0 Datation Preamble Field (DPF) - The number of coarse and fine time implemented can be obtained from this Preamble Field.

Table 454. 0x044 - DET0 - Datation Elapsed Time 0

31	0
DET0	
0	

# LEON3FT Microcontroller

Table 454.0x044 - DET0 - Datation Elapsed Time 0

r
---

31: 0      Datation Elapsed Time 0 (DET0) - CCSDS Time Code value (0 to 31) of local ET counter value.

Table 455.0x048 - DET1 - Datation Elapsed Time 1

31	0
DET1	
0	
r	

31: 0      Datation Elapsed Time 1 (DET1) - CCSDS Time Code value (32 to 63) of local ET counter value.

Table 456. 0x060 - TRPFRX - Time-Stamp Preamble Field Rx

31	16	15	0
RESERVED		TRPF	
0		0x2f00	
r		r	

31: 16      RESERVED

15: 0      Time stamp Preamble Field (TRPF) - The number of coarse and fine time implemented can be obtained from this Preamble Field.

Table 457. 0x064 - TR0 - Time Stamp Elapsed Time 0 Rx

31	0
TR0	
0	
r	

31: 0      Time Stamp Elapsed Time 0 Rx (TR0) - Time stamped local ET value (0 To 31) when distributed interrupt received.

Table 458. 0x068 - TR1 - Time Stamp Elapsed Time 1 Rx

31	0
TR1	
0	
r	

31: 0      Time Stamp Elapsed Time 1 Rx (TR1) - Time stamped local ET value (32 to 63) when distributed interrupt received.

Table 459. 0x080 - TTPFTX - Time-Stamp SpaceWire Time-Code and Preamble Field Tx

31	24	23	16	15	0
TSTC		RESERVED		TTPF	
0		0		0x2f00	
rw		r		r	

31: 24      Time stamp time code (TSTC) - Time stamp on this time-code value, used for time stamping when this register matched with SpaceWire Time-Codes. The mask for this matching is available in configuration register 3.(only for initiator)

23: 16      RESERVED

15: 0      Time stamp Preamble Field (TTPF) - The number of coarse and fine time implemented can be obtained from this Preamble Field.

# LEON3FT Microcontroller

Table 460. 0x084 - TT0 - Time Stamp Elapsed Time 0 Tx

31		0
	TT0	
	0	
	r	

31: 0 Time Stamp Elapsed Time 0 Tx (TT0) - Time stamped local ET value (0 to 31) when distributed interrupt transmitted.

Table 461. 0x088 - TT1 - Time Stamp Elapsed Time 1 Tx

31		0
	TT1	
	0	
	r	

31: 0 Time Stamp Elapsed Time 1 Tx (TT1) - Time stamped local ET value (32 to 63) when distributed interrupt transmitted.

Table 462. 0x0A0 - LPF- Latency Preamble Field

31	16	15	0
	RESERVED		LPF
	0		0x2f00
	r		r

31: 16 RESERVED

15: 0 Latency Preamble Field (LPF) - The number of coarse and fine time implemented can be obtained from this Preamble Field.(only for target)

Table 463. 0xA4 - LE0 -Latency Elapsed Time 0

31		0
	LE0	
	0	
	rw	

31: 0 Latency Elapsed Time Value 0 (LE0) - Latency Value (0 to 31) written by initiator.(only for target)

Table 464. 0xA8 - LE1 -Latency Elapsed Time 1

31		0
	LE1	
	0	
	rw	

31: 0 Latency Elapsed Time Value 1 (LE1) - Latency Value (32 to 63) written by initiator.(only for target)

# LEON3FT Microcontroller

Table 465. 0x0C0 - IE - Interrupt Enable

31	20	19	18	11	10	9	8	7	6	5	4	3	2	1	0
-	NCTCE	-	-	SETE	EDIE3	EDIE2	EDIE1	EDIE0	DITE	DIRE	TTE	TME	TRE	SE	
0	0	0	0	0	0										
r	rw	r	r	rw	rw										

- 31: 20      RESERVED
- 19:        Non consecutive SpaceWire Time-Code received Interrupt Enable (NCTCE)
- 18: 11      RESERVED
- 10         Set ET External Interrupt Enable (SETE)
- 9          External Datation Interrupt Enable 3 (EDIE3)
- 8          External Datation Interrupt Enable 2 (EDIE2)
- 7          External Datation Interrupt Enable 1 (EDIE1)
- 6          External Datation Interrupt Enable 0 (EDIE0)
- 5          Distributed Interrupt Transmitted Interrupt Enable (DITE)
- 4          Distributed interrupt Received Interrupt Enable (DIRE)
- 3          Time-Code Transmitted Interrupt Enable (TTE) - SpaceWire Time-Code Transmitted Interrupt Enable (only for initiator)
- 2          Time Message transmit Interrupt Enable (TME) - (only for initiator)
- 1          Time-Code Received Interrupt Enable (TRE) - SpaceWire Time-Code Received Interrupt Enable (only for target)
- 0          Sync Interrupt Enable (SE) (only for target)

Table 466. 0xC4 - IS -Interrupt Status

31	20	19	18	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED	NCTC	-	-	SET	EDI3	EDI2	EDI1	EDI0	DIT	DIR	TT	TM	TR	S	
0	0	0	0	0	0										
r	wc	r	r	wc	wc										

- 31: 20      RESERVED
- 19:        Generated when Non consecutive SpaceWire Time-Code is received (NCTC)
- 18: 11      RESERVED
- 10         Generated when Elapsed Time is loaded with contents of the Command Field register based on external enable signal (SET).
- 9          External Datation Interrupt 3 (EDI3) - Generated when conditions for External Datation 3 is matched.
- 8          External Datation Interrupt 2 (EDI2) - Generated when conditions for External Datation 2 is matched.
- 7          External Datation Interrupt 1 (EDI1) - Generated when conditions for External Datation 1 is matched.
- 6          External Datation Interrupt 0 (EDI0) - Generated when conditions for External Datation 0 is matched.
- 5          Distributed Interrupt Transmitted (DIT) - Generated when distributed interrupt is transmitted (Latency calculation should be enabled)
- 4          Distributed interrupt Received (DIR) - Generated when distributed interrupt is Received (Latency calculation should be enabled)
- 3          Time-Codes Transmitted (TT) - Generated when SpaceWire Time-Codes is transmitted (only for initiator)



# LEON3FT Microcontroller

Table 466. 0xC4 - IS -Interrupt Status

- 2 Transmit Time Message (TM) - Generated when the conditions for transmitting time message occurred, based on this time message should be transmitted from initiator (only for initiator)
- 1 Time-Code Received (TR) - Generated when SpaceWire Time-Code is received (only for target)
- 0 Target initialized or synchronized (S) - Generated when the target is initialized or synchronized with initiator (only for target)

Table 467. 0xC8 - DC - Delay Count

31	-	15 14	0
	-		DC
	0		0x7FFF
	r		rw

31: 15 RESERVED

14: 0 Delay Count (DC) - Delay induced between SpaceWire Time-Codes and Distributed Interrupt transmission in system clock units. The delay introduced is the value in this register multiplied by the system clock.  
(only for initiator)0x7FFF

Table 468. 0xCC - DS - Disable Sync

31 30	-	24 23	0
EN	-		CD
0	0		0xFFFFF
rw	r		rw

31: Enable for Configurable delay (EN)

30: 24 RESERVED

23: 0 Configurable delay (CD) to capture missing SpaceWire Time-Code (only for target)

The INSYNC bit in the Status 0 register will disable itself when an expected SpaceWire Time-Code is not arrived after the delay mentioned in this register. The delay corresponds to the fine time of Elapsed Time counter and should not overlap with the MAPPING register. Any Overlapping register must also be set to Zero.

Table 469. 0x100 - EDM0 - External Datation 0 Mask

31	-	0
		EDM0
		0x00000000
		rw

31: 0 External Datation Mask (EDM0) - External datation can be enabled by writing '1' into the bit for that corresponding external input. When conditions are matched the Elapsed Time will be latched.

The latched values are available at External Datation 0 Time Register.

All the mask bits will go low after any one of the conditions with respect to the enabled mask bits are matched.

Table 470. 0x110 - EDPF0 - External Datation 0 Preamble Field

31	-	16 15	0
	-		EDPF0
	0		0x2f00
	r		r

31: 16 RESERVED

15: 0 External Datation Preamble Field (EDPF0) - The number of coarse and fine time implemented can be obtained from this Preamble Field.

# LEON3FT Microcontroller

Table 471.0x114 - ED0ET0 - External Datation 0 Elapsed Time 0

31	0
ED0ET0	
0	
r	

31: 0 External Datation Elapsed Time 0 (ED0ET0) - Latched CCSDS Time Code value (0 to 31) of local ET counter.

Table 472.0x118 - ED0ET1 - External Datation 0 Elapsed Time 1

31	0
ED0ET1	
0	
r	

31: 0 External Datation Elapsed Time 1 (ED0ET1) - Latched CCSDS Time Code value (32 to 63) of local ET counter.

**Note:**

Reserved register fields should be written as zeros and masked out on read.

The registers which are not mentioned either as only for initiator or target are used in both initiator and target.

The Definition of External Datation 1 Mask, External Datation 2 Mask and External Datation 3 Mask registers are exactly same as External Datation 0 Mask Register.

The Definition of External Datation 1 Time, External Datation 2 Time and External Datation 3 Time registers are exactly same as External Datation 0 Time Registers (i.e. External Datation 0 Preamble Field and External Datation 0 Elapsed Time 0,1,2,3,4).

# LEON3FT Microcontroller

## 35 General Purpose Timer Unit with Watchdog

### 35.1 Overview

The General Purpose Timer Unit provides a common prescaler and 7 decrementing timers. The unit is capable of asserting interrupts on timer underflow. The timer also provides the system with watchdog functionality. The watchdog is of window-watchdog type i.e. the watchdog timer can be configured to have a lower boundary and for how often the watchdog timer can be triggered or reloaded by the software.

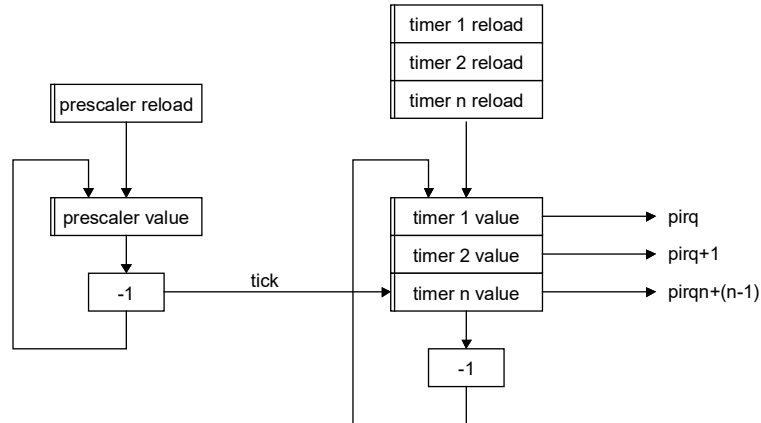


Figure 66. General Purpose Timer Unit block diagram

### 35.2 Operation

The prescaler is clocked by the system clock and decremented on each clock cycle. When the prescaler underflows, it is reloaded from the prescaler reload register and a timer tick is generated.

The operation of each timers is controlled through its control register. A timer is enabled by setting the enable bit in the control register. The timer value is then decremented on each prescaler tick. When a timer underflows, it will automatically be reloaded with the value of the corresponding timer reload register if the restart bit in the control register is set, otherwise it will stop at -1 and reset the enable bit.

The shared interrupt will be raised when any of the timers with interrupt enable bit underflows. The timer unit will signal an interrupt on appropriate line when a timer underflows (if the interrupt enable bit for the current timer is set). The interrupt pending bit in the control register of the underflow timer will be set and remain set until cleared by writing '1'.

To minimize complexity, timers share the same decremter. This means that the minimum allowed prescaler division factor is  $8$  (reload register =  $7$ ) where  $7$  is the number of timers. By setting the chain bit in the control register timer  $n$  can be chained with preceding timer  $n-1$ . Timer  $n$  will be decremented each time when timer  $n-1$  underflows.

Each timer can be reloaded with the value in its reload register at any time by writing a 'one' to the load bit in the control register. The last timer acts as a watchdog, asserting the external RESET\_OUT\_N output signal when expired. The watchdog timer also implements a window functionality. This enables a decremting counter which reloads each time the timer is reloaded. If the timer is reloaded and the window counter hasn't reach zero, this will also assert the RESET\_OUT\_N output.

# LEON3FT Microcontroller

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Each timer can be configured to latch its value to a dedicated register when an event is detected on the interrupt. All timers can be forced to reload when an event is detected on the interrupt bus. A dedicated mask register is provided to filter the interrupts.

Simultaneous start of multiple timers are supported via timer configuration register CONFIG.TIMEREN. To simultaneously start two or more counters set the corresponding bits in the register CONFIG.TIMEREN.

At reset, all timer are disabled except the watchdog timer. The prescaler value and reload registers are set to all ones, while the watchdog timer 7 is set to 0xFFFF. All other registers are uninitialized except for the WDOGDIS and WDOGNMI fields that are reset to '0'.

## 35.2.1 Window-watchdog

The watchdog has an optional lower boundary for reloading the watchdog timer. Application can optionally specify the least number of system clock cycles between 2 reload events of the watchdog timer.

When a watchdog window is programmed, an early watchdog reload is also treated as a watchdog event. This allows preventing situations where a system failure may still reload the watchdog. For example, application code could be stuck in an interrupt service that contains a watchdog feed. Setting the window such that this would result in an early reload will generate a watchdog event, allowing for system recovery.

The watchdog window functionality is enabled when the bit field WDOGWINC is greater than 0x0 and smaller or equal to 0xFFFF. The programmed number specify the number of system clock cycles between 2 watchdog reload events.

# LEON3FT Microcontroller

## 35.3 Registers

The core is programmed through registers mapped into APB address space. The number of implemented registers depend on the number of implemented timers.

Table 473. General Purpose Timer Unit registers

APB address offset	Register
0x80003000	Scaler value
0x80003004	Scaler reload value
0x80003008	Configuration register
0x8000300C	Timer latch configuration register
0x80003010	Timer 1 counter value register
0x80003014	Timer 1 reload value register
0x80003018	Timer 1 control register
0x8000301C	Timer 1 latch register
0x80003020	Timer 2 counter value register
0x80003024	Timer 2 reload value register
0x80003028	Timer 2 control register
0x8000302C	Timer 2 latch register
0x80003030	Timer 3 counter value register
0x80003034	Timer 3 reload value register
0x80003038	Timer 3 control register
0x8000303C	Timer 3 latch register
0x80003040	Timer 4 counter value register
0x80003044	Timer 4 reload value register
0x80003048	Timer 4 control register
0x8000304C	Timer 4 latch register
0x80003050	Timer 5 counter value register
0x80003054	Timer 5 reload value register
0x80003058	Timer 5 control register
0x8000305C	Timer 5 latch register
0x80003060	Timer 6 counter value register
0x80003064	Timer 6 reload value register
0x80003068	Timer 6 control register
0x8000306C	Timer 6 latch register
0x80003070	Timer 7 counter value register
0x80003074	Timer 7 reload value register
0x80003078	Timer 7 control register
0x8000307C	Timer 7 latch register

# LEON3FT Microcontroller

## 35.3.1 Scaler Value Register

Table 474.0x00 - SCALER - Scaler value register

31	16	16-1	0
RESERVED		SCALER	
0		all 1	
r		rw	

16-1: 0      Scaler value. This value will also be set by writes to the Scaler reload value register.  
Any unused most significant bits are reserved. Always reads as '000...0'.

## 35.3.2 Scaler Reload Value Register

Table 475.0x04 - SRELOAD - Scaler reload value register

31	16	16-1	0
RESERVED		SCALER RELOAD VALUE	
0		all 1	
r		rw	

16-1: 0      Scaler reload value. Writes to this register also set the scaler value.  
Any unused most significant bits are reserved. Always read as '000...0'.

# LEON3FT Microcontroller

## 35.3.3 Configuration Register

Table 476.0x08 - CONFIG - Configuration register

31	23	22	16	15	14	13	12	11	10	9	8	7	3	2	0
RESERVED			TIMEREN			R	EV	ES	EL	EE	DF	SI	RESERVED		TIMERS
0			0			0	0	0	0	0	0	1	*		7
r			rw			r	rw	rw	rw	rw	rw	r	r		r

- 31: 23      Reserved. Always reads as ‘000...0’.
- 22: 16      Enable bits for each timer. Writing ‘1’ to one of this bits sets the enable bit in the corresponding timers control register. Writing ‘0’ has no effect to the timers. bit[16] corresponds to timer0, bit[17] to timer 1,...
- 15: 14      Reserved
- 13          External Events (EV). If EV is set to 0 then the latch and set events are taken from the least significant 32 bit of the interrupt bus, otherwise they are from some of the most significant ones and some external signals (see table 35.3.4)
- 12          Enable set (ES). If set, on the next matching interrupt, the timers will be loaded with the corresponding timer reload values. The bit is then automatically cleared, not to reload the timer values until set again.
- 11          Enable latching (EL). If set, on the next matching interrupt, the latches will be loaded with the corresponding timer values. The bit is then automatically cleared, not to load a timer value until set again.
- 10          Enable external clock source (EE). If set the prescaler is clocked from the external clock source.
- 9            Disable timer freeze (DF). If set the timer unit can not be freezed, otherwise signal GPTI.DHALT freezes the timer unit.
- 8            Separate interrupts (SI). Reads ‘1’ if the timer unit generates separate interrupts for each timer, otherwise ‘0’. Read-only.
- 7: 3        Reserved
- 2: 0        Number of implemented timers. Read-only.

## 35.3.4 Timer Latch Configuration Register

Table 477.0x0C - CATCHCFG - Timer latch configuration register

31	0
LATCHSEL	
0	
rw	

- 31: 0      This field specifies which bits of the interrupt bus or of the external signals (depending on EV field in table 35.3.3) cause the set and latch events. If EV is 0, the latching is done based on events on the 31:0 bits of the interrupt bus with a direct mapping. If the EV field is ‘1’, the bits 29:0 correspond to the 61:32 bits of the interrupt bus, while the bit 30 corresponds to the TICKOUT signal from the SpaceWire Interface (see chapter 33) and the bit 31 corresponds to the rtsync signal from the MIL-STD-1553B / AS15531 Interface (see chapter 23).

## 35.3.5 Timer N Counter Value Register

Table 478.0xn0, when n selects the times - TCNTVALn - Timer n counter value register

32-1	0
TCVAL	
0	
rw	

- 32-1: 0      Timer Counter value. Decremented by 1 for each prescaler tick.  
Any unused most significant bits are reserved. Always reads as ‘000...0’.

# LEON3FT Microcontroller

## 35.3.6 Timer N Reload Value Register

Table 479.0xn4, when n selects the times - TRLDVALn - Timer n reload value register

32-1	0
TRCDUAL	
*	
rw	

- 32-1: 0      Timer Reload value. This value is loaded into the timer counter value register when ‘1’ is written to load bit in the timers control register or when the RS bit is set in the control register and the timer underflows.  
Any unused most significant bits are reserved. Always reads as ‘000...0’.

## 35.3.7 Timer N Control Register

Table 480.0xn8, when n selects the times - TCTRLn - Timer n control register

31	16 15	9	8	7	6	5	4	3	2	1	0	
WDOGWINC		RESERVED		WS	WN	DH	CH	IP	IE	LD	RS	EN
0		0		0	0	0	0	0	0	0	*	*
rw		r		rw	rw	r	rw	wc	wc	rw	rw	rw

- 31: 16      Reload value for the watchdog window counter. The window counter is reloaded with this value each time the watchdog counter is reloaded. This register is only available for counter timer 7 in timer unit #1.
- 15: 9      Reserved. Always reads as ‘000...0’.
- 8          Disable Watchdog Output (WS/WDOGDIS): If this field is set to ‘1’ then the GPTO.WDOG and GPTO.WDOGN outputs are disabled (fixed to ‘0’ and ‘1’ respectively). This functionality is only available for the last timer.
- 7          Enable Watchdog NMI (WN/WDOGNMI): If this field is set to ‘1’ then the watchdog timer will also generate a non-maskable interrupt (15) when an interrupt is signalled. This functionality is only available for the last timer
- 6          Debug Halt (DH): Value of GPTI.DHALT signal which is used to freeze counters (e.g. when a system is in debug mode). Read-only.
- 5          Chain (CH): Chain with preceding timer. If set for timer *n*, timer *n* will be decremented each time when timer (*n*-1) underflows.
- 4          Interrupt Pending (IP): The core sets this bit to ‘1’ when an interrupt is signalled. This bit remains ‘1’ until cleared by writing ‘1’ to this bit, writes of ‘0’ have no effect.
- 3          Interrupt Enable (IE): If set the timer signals interrupt when it underflows.
- 2          Load (LD): Load value from the timer reload register to the timer counter value register.
- 1          Restart (RS): If set, the timer counter value register is reloaded with the value of the reload register when the timer underflows
- 0          Enable (EN): Enable the timer.

## 35.3.8 Timer N Latch Register

Table 481.0xnC, when n selects the times - TLATCHn - Timer n latch register

31	0
LTCV	
0	
r	

- 31: 0      Latched timer counter value (LTCV): Valued latched from corresponding timer. Read-only.



# LEON3FT Microcontroller

## 36 General Purpose Timer Unit (Secondary)

### 36.1 Overview

The secondary LEON3FT microcontroller have 2 General Purpose Timer Units. The General Purpose Timer Unit provides a common prescaler and 7 decrementing timers. The unit is capable of asserting interrupts on timer underflow.

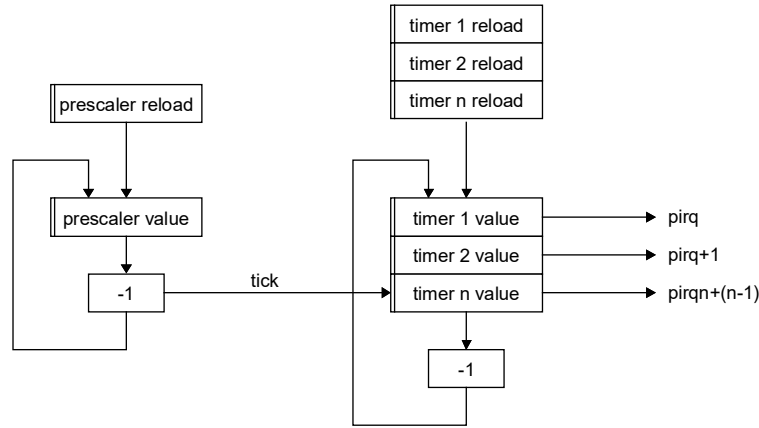


Figure 67. General Purpose Timer Unit block diagram

### 36.2 Operation

The prescaler is clocked by the system clock and decremented on each clock cycle. When the prescaler underflows, it is reloaded from the prescaler reload register and a timer tick is generated.

The operation of each timers is controlled through its control register. A timer is enabled by setting the enable bit in the control register. The timer value is then decremented on each prescaler tick. When a timer underflows, it will automatically be reloaded with the value of the corresponding timer reload register if the restart bit in the control register is set, otherwise it will stop at -1 and reset the enable bit.

The shared interrupt will be raised when any of the timers with interrupt enable bit underflows. The timer unit will signal an interrupt on appropriate line when a timer underflows (if the interrupt enable bit for the current timer is set). The interrupt pending bit in the control register of the underflown timer will be set and remain set until cleared by writing '1'.

To minimize complexity, timers share the same decremter. This means that the minimum allowed prescaler division factor is 8 (reload register = 7) where 7 is the number of timers. By setting the chain bit in the control register timer  $n$  can be chained with preceding timer  $n-1$ . Timer  $n$  will be decremented each time when timer  $n-1$  underflows.

Each timer can be reloaded with the value in its reload register at any time by writing a 'one' to the load bit in the control register.

Each timer can be configured to latch its value to a dedicated register when an event is detected on the interrupt. All timers can be forced to reload when an event is detected on the interrupt bus A dedicated mask register is provided to filter the interrupts.

Simultaneous start of multiple timers are supported via timer configuration register CONFIG.TIMEREN. To simultaneously start two or more counters set the corresponding bits in the register CONFIG.TIMEREN.

# LEON3FT Microcontroller

## 36.3 Registers

The core is programmed through registers mapped into APB address space. The number of implemented registers depend on the number of implemented timers.

Table 482. General Purpose Timer Unit registers

APB address offset	Register
0x80004000	Scaler value
0x80004004	Scaler reload value
0x80004008	Configuration register
0x8000400C	Timer latch configuration register
0x80004010	Timer 1 counter value register
0x80004014	Timer 1 reload value register
0x80004018	Timer 1 control register
0x8000401C	Timer 1 latch register
0x80004020	Timer 2 counter value register
0x80004024	Timer 2 reload value register
0x80004028	Timer 2 control register
0x8000402C	Timer 2 latch register
0x80004030	Timer 3 counter value register
0x80004034	Timer 3 reload value register
0x80004038	Timer 3 control register
0x8000403C	Timer 3 latch register
0x80004040	Timer 4 counter value register
0x80004044	Timer 4 reload value register
0x80004048	Timer 4 control register
0x8000404C	Timer 4 latch register
0x80004050	Timer 5 counter value register
0x80004054	Timer 5 reload value register
0x80004058	Timer 5 control register
0x8000405C	Timer 5 latch register
0x80004060	Timer 6 counter value register
0x80004064	Timer 6 reload value register
0x80004068	Timer 6 control register
0x8000406C	Timer 6 latch register
0x80004070	Timer 7 counter value register
0x80004074	Timer 7 reload value register
0x80004078	Timer 7 control register
0x8000407C	Timer 7 latch register

# LEON3FT Microcontroller

## 36.3.1 Scaler Value Register

Table 483.0x00 - SCALER - Scaler value register

31	16	16-1	0
RESERVED		SCALER	
0		all 1	
r		rw	

16-1: 0      Scaler value. This value will also be set by writes to the Scaler reload value register.  
Any unused most significant bits are reserved. Always reads as '000...0'.

## 36.3.2 Scaler Reload Value Register

Table 484.0x04 - SRELOAD - Scaler reload value register

31	16	16-1	0
RESERVED		SCALER RELOAD VALUE	
0		all 1	
r		rw	

16-1: 0      Scaler reload value. Writes to this register also set the scaler value.  
Any unused most significant bits are reserved. Always read as '000...0'.

# LEON3FT Microcontroller

## 36.3.3 Configuration Register

Table 485.0x08 - CONFIG - Configuration register

31	23	22	16	15	14	13	12	11	10	9	8	7	3	2	0
"000..0"			TIMEREN			R	EV	ES	EL	EE	DF	SI	RESERVED		TIMERS
0			0			0	0	0	0	0	0	1	*		7
r			rw			r	rw	rw	rw	rw	rw	r	r		r

- 31: 23      Reserved. Always reads as '000...0'.
- 22: 16      Enable bits for each timer. Writing '1' to one of this bits sets the enable bit in the corresponding timers control register. Writing '0' has no effect to the timers. bit[16] corresponds to timer0, bit[17] to timer 1,...
- 15: 14      Reserved
- 13          External Events (EV). If EV is set to 0 then the latch and set events are taken from the least significant 32 bit of the interrupt bus, otherwise they are from some of the most significant ones and some external signals (see table 35.3.4).
- 12          Enable set (ES). If set, on the next matching interrupt, the timers will be loaded with the corresponding timer reload values. The bit is then automatically cleared, not to reload the timer values until set again.
- 11          Enable latching (EL). If set, on the next matching interrupt, the latches will be loaded with the corresponding timer values. The bit is then automatically cleared, not to load a timer value until set again.
- 10          Enable external clock source (EE). If set the prescaler is clocked from the external clock source.
- 9            Disable timer freeze (DF). If set the timer unit can not be freezed, otherwise signal GPTI.DHALT freezes the timer unit.
- 8            Separate interrupts (SI). Reads '1' if the timer unit generates separate interrupts for each timer, otherwise '0'. Read-only.
- 7: 3        Reserved
- 2: 0        Number of implemented timers. Read-only.

## 36.3.4 Timer Latch Configuration Register

Table 486.0x0C - CATCHCFG - Timer latch configuration register

31	0
LATCHSEL	
0	
rw	

- 31: 0      This field specifies which bits of the interrupt bus or of the external signals (depending on EV field in table 35.3.3) cause the set and latch events. If EV is 0, the latching is done based on events on the 31:0 bits of the interrupt bus with a direct mapping. If the EV field is '1', the bits 29:0 correspond to the 61:32 bits of the interrupt bus, while the bit 30 corresponds to the TICKOUT signal from the SpaceWire Interface (see chapter 33) and the bit 31 corresponds to the rtsync signal from the MIL-STD-1553B / AS15531 Interface (see chapter 23).

## 36.3.5 Timer N Counter Value Register

Table 487.0xn0, when n selects the times - TCNTVALn - Timer n counter value register

32-1	0
TCVAL	
0	
rw	

- 32-1: 0      Timer Counter value. Decremented by 1 for each prescaler tick.  
Any unused most significant bits are reserved. Always reads as '000...0'.

# LEON3FT Microcontroller

## 36.3.6 Timer N Reload Value Register

Table 488.0xn4, when n selects the times - TRLDVALn - Timer n reload value register

32-1	0
TRCDUAL	
*	
rw	

- 32-1: 0      Timer Reload value. This value is loaded into the timer counter value register when '1' is written to load bit in the timers control register or when the RS bit is set in the control register and the timer underflows.  
Any unused most significant bits are reserved. Always reads as '000...0'.

## 36.3.7 Timer N Control Register

Table 489.0xn8, when n selects the times - TCTRLn - Timer n control register

31	9	8	7	6	5	4	3	2	1	0
RESERVED				DH	CH	IP	IE	LD	RS	EN
0				0	0	0	0	0	*	*
r				r	rw	wc	wc	rw	rw	rw

- 31: 7      Reserved. Always reads as '000...0'.
- 6      Debug Halt (DH): Value of GPTI.DHALT signal which is used to freeze counters (e.g. when a system is in debug mode). Read-only.
- 5      Chain (CH): Chain with preceding timer. If set for timer *n*, timer *n* will be decremented each time when timer (*n*-1) underflows.
- 4      Interrupt Pending (IP): The core sets this bit to '1' when an interrupt is signalled. This bit remains '1' until cleared by writing '1' to this bit, writes of '0' have no effect.
- 3      Interrupt Enable (IE): If set the timer signals interrupt when it underflows.
- 2      Load (LD): Load value from the timer reload register to the timer counter value register.
- 1      Restart (RS): If set, the timer counter value register is reloaded with the value of the reload register when the timer underflows
- 0      Enable (EN): Enable the timer.

## 36.3.8 Timer N Latch Register

Table 490.0xnC, when n selects the times - TLATCHn - Timer n latch register

31	0
LTCV	
0	
r	

- 31: 0      Latched timer counter value (LTCV): Valued latched from corresponding timer. Read-only.

# LEON3FT Microcontroller

## 37 I<sup>2</sup>C to AHB bridge

The GR716 microcontroller comprises an I<sup>2</sup>C to AHB bridge (I2C2AHB). The I<sup>2</sup>C to AHB bridge controls its own external pins and has a unique AMBA address described in chapter 2.10. The I<sup>2</sup>C to AHB bridge is connected to external pins via the IOMUX.

The control and status registers are located on APB bus in the address range from 0x80105000 to 0x80105FFF. See I<sup>2</sup>C to AHB bridge connections in the next drawing. The figure shows memory locations and functions used for I2C2AHB configuration and control.

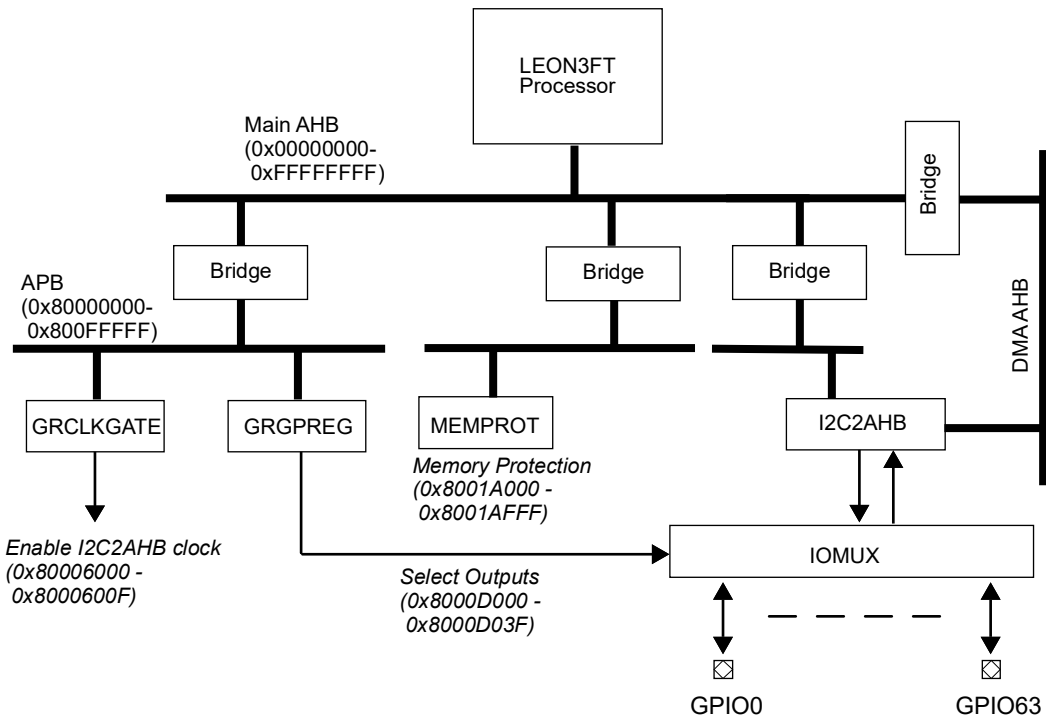


Figure 68. GR716 I2C2AHB bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the I<sup>2</sup>C to AHB bridge. The unit **GRCLKGATE** can also be used to perform reset of the I<sup>2</sup>C to AHB bridge. Software must enable clock and release reset described in section 27 before configuration and transmission can start.

External IO selection and configuration is made in the system IO configuration registers (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

The system can be configured to protect and restrict access to the I<sup>2</sup>C to AHB bridge in the **MEMPROT** unit. See section 47 for more information.

### 37.1 Overview

The I<sup>2</sup>C slave to AHB bridge is an I<sup>2</sup>C slave that provides a link between the I<sup>2</sup>C bus and AMBA AHB. The core is compatible with the Philips I<sup>2</sup>C standard and external pull-up resistors must be supplied for both bus lines.

On the I<sup>2</sup>C bus the slave acts as an I<sup>2</sup>C memory device where accesses to the slave are translated to AMBA accesses. The core can translate I<sup>2</sup>C accesses to AMBA byte, halfword or word accesses. The core makes use of I<sup>2</sup>C clock stretching but can also be configured to use a special mode without clock

stretching in order to support systems where master or physical layer limitations prevent stretching of the I<sup>2</sup>C clock period.

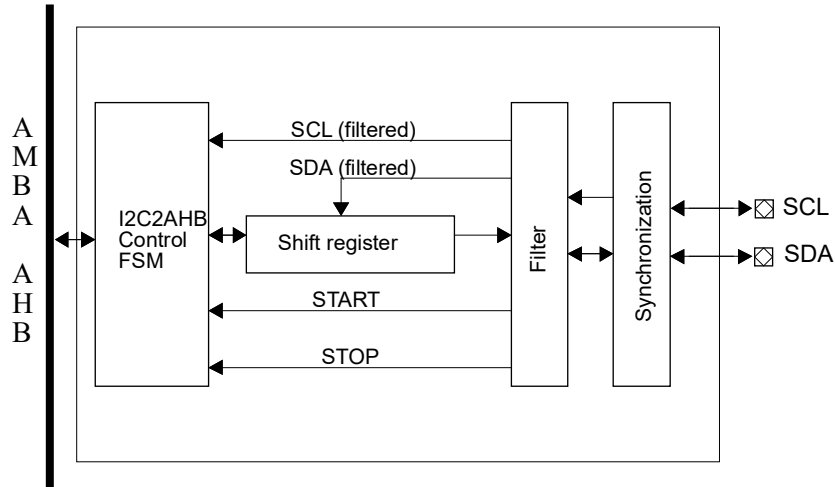


Figure 69. Block diagram

## 37.2 Operation

### 37.2.1 Transmission protocol

The I<sup>2</sup>C-bus is a simple 2-wire serial multi-master bus with collision detection and arbitration. The bus consists of a serial data line (SDA) and a serial clock line (SCL). The I<sup>2</sup>C standard defines three transmission speeds; Standard (100 kb/s), Fast (400 kb/s) and High speed (3.4 Mb/s).

A transfer on the I<sup>2</sup>C-bus begins with a START condition. A START condition is defined as a high to low transition of the SDA line while SCL is high. Transfers end with a STOP condition, defined as a low to high transition of the SDA line while SCL is high. These conditions are always generated by a master. The bus is considered to be busy after the START condition and is free after a certain amount of time following a STOP condition. The bus free time required between a STOP and a START condition is defined in the I<sup>2</sup>C-bus specification and is dependent on the bus bit rate.

Figure 70 shows a data transfer taking place over the I<sup>2</sup>C-bus. The master first generates a START condition and then transmits the 7-bit slave address. The bit following the slave address is the R/ $\bar{W}$  bit which determines the direction of the data transfer. In this case the R/ $\bar{W}$  bit is zero indicating a write operation. After the master has transmitted the address and the R/ $\bar{W}$  bit it releases the SDA line. The receiver pulls the SDA line low to acknowledge the transfer. If the receiver does not acknowledge the transfer, the master may generate a STOP condition to abort the transfer or start a new transfer by generating a repeated START condition.

After the address has been acknowledged the master transmits the data byte. If the R/ $\bar{W}$  bit had been set to '1' the master would have acted as a receiver during this phase of the transfer. After the data byte has been transferred the receiver acknowledges the byte and the master generates a STOP condition to complete the transfer.

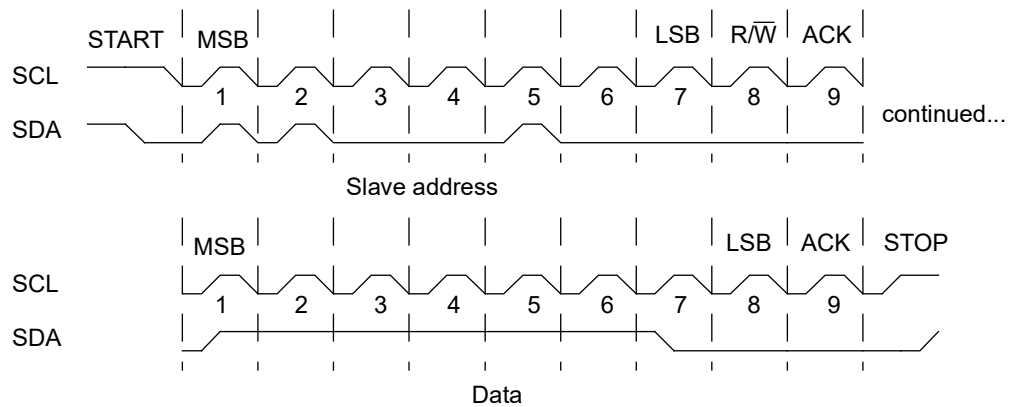


Figure 70. Complete I<sup>2</sup>C data transfer

If the data bit rate is too high for a slave device or if the slave needs time to process data, it may stretch the clock period by keeping SCL low after the master has driven SCL low. Clock stretching is a configurable parameter of the core (see sections 37.2.4 and 37.2.6).

### 37.2.2 Slave addressing

The core responds to two addresses on the I<sup>2</sup>C bus. Accesses to the I<sup>2</sup>C memory address are translated to AMBA AHB accesses and accesses to the I<sup>2</sup>C configuration address access the core’s configuration register. I<sup>2</sup>C memory and slave addresses can be configured via control registers see register SLVADDR and SLVCFG in section 37.3.5 and 37.3.6.

### 37.2.3 System clock requirements and sampling

The core samples the incoming I<sup>2</sup>C SCL clock and does not introduce any additional clock domains into the system. Both the SCL and SDA lines first pass through two stage synchronizers and are then filtered with a low pass filter consisting of four registers.

START and STOP conditions are detected if the SDA line, while SCL is high, is at one value for two system clock cycles, toggles and keeps the new level for two system clock cycles.

The synchronizers and filters constrain the minimum system frequency. The core requires the SCL signal to be stable for at least four system clock cycles before the core accepts the SCL value as the new clock value. The core’s reaction to transitions will be additionally delayed since both lines are taken through two-stage synchronizers before they are filtered. Therefore it takes the core over eight system clock cycles to discover a transition on SCL.

### 37.2.4 Configuration register access

The I<sup>2</sup>C configuration register is accessed via a separate I<sup>2</sup>C address (I<sup>2</sup>C configuration address). The configuration register has the layout shown in table 491.

Table 491. I2C2AHB configuration register

7	6	5	4	3	2	1	0
Reserved	PROT	MEXC	DMAACT	NACK	HSIZE		

- 7:6 Reserved, always zero (read only)
- 5 Memory protection triggered (PROT) - ‘1’ if last AHB access was outside the allowed memory area. Updated after each AMBA access (read only)
- 4 Memory exception (MEXC) - ‘1’ if core receives AMBA ERROR response. Updated after each AMBA access (read only)
- 3 DMA active (DMAACT) - ‘1’ if core is currently performing a DMA operation.



# LEON3FT Microcontroller

Table 491. I2C2AHB configuration register

2	NACK (NACK) - Use NACK instead of clock stretching. See documentation in section 37.2.6.
1:0	AMBA access size (HSIZE) - Controls the access size that the core will use for AMBA accesses. 0: byte, 1: halfword, 2: word. HSIZE = "11" is illegal.

Reset value: 0x02

Reads from the I<sup>2</sup>C configuration address will return the current value of the configuration register. Writes to the I<sup>2</sup>C configuration address will affect the writable bits in the configuration register.

## 37.2.5 AHB accesses

All AMBA accesses are done in big endian format. The first byte sent to or from the slave is the most significant byte.

To write a word on the AHB bus the following I2C bus sequence should be performed:

1. Generate START condition
2. Send I2C memory address with the  $R/\overline{W}$  bit set to '0'.
3. Send four byte AMBA address, the most significant byte is transferred first
4. Send four bytes to write to the specified address
5. If more than four consecutive bytes should be written, continue to send additional bytes, otherwise go to 6.
6. Generate STOP condition

To perform a read access on the AHB bus, the following I2C bus sequence should be performed:

1. Generate START condition
2. Send I2C memory address with the  $R/\overline{W}$  bit set to '0'.
3. Send four byte AMBA address, the most significant byte is transferred first
4. Generate (repeated) START condition
5. Send I2C memory address with the  $R/\overline{W}$  bit set to '1'.
6. Read the required number of bytes and NACK the last byte
7. Generate stop condition

During consecutive read or write operations, the core will automatically increment the address. The access size (byte, halfword or word) used on AHB is set via the HSIZE field in the I2C2AHB configuration register.

The core always respects the access size specified via the HSIZE field. If a write operation writes fewer bytes than what is required to do an access of the specified HSIZE then the write data will be dropped, no access will be made on AHB. If a read operation reads fewer bytes than what is specified by HSIZE then the remaining read data will be dropped at a START or STOP condition. This means, for instance, that if HSIZE is "10" (word) the core will perform two word accesses if a master reads one byte, generates a repeated start condition, and reads one more byte. Between these two accesses the address will have been automatically increased, so the first access will be to address  $n$  and the second to address  $n+4$ .

The automatic address increment means that it is possible to write data and then immediately read the data located at the next memory position. As an example, the following sequence will write a word to address 0 and then read a word from address 4:

1. Generate START condition
2. Send I2C memory address with the  $R/\overline{W}$  bit set to '0'.
3. Send four byte AMBA address, all zero.
4. Send four bytes to write to the specified address

5. Generate (repeated) START condition
6. Send I2C memory address with the  $R/\overline{W}$  bit set to '1'.
7. Read the required number of bytes and lack the last byte
8. Generate stop condition

The core will not mask any address bits. Therefore it is important that the I<sup>2</sup>C master respects AMBA rules when performing halfword and word accesses. A halfword access must be aligned on a two byte address boundary (least significant bit of address must be zero) and a word access must be aligned on a four byte boundary (two least significant address bits must be zero).

### 37.2.6 Clock stretching or NACK mode

The core has two main modes of operation for AMBA accesses. In one mode the core will use clock stretching while performing an AHB operation and in the other mode the core will not acknowledge bytes (abort the I<sup>2</sup>C access) when the core is busy. Clock stretching is the preferred mode of operation. The NACK mode can be used in scenarios where the I<sup>2</sup>C master or physical layer does not support clock stretching. The mode to use is selected via the NACK field in the I<sup>2</sup>C configuration register.

When clock stretching is enabled (NACK field is '0') the core will stretch the clock when the slave is accessed (via the I2C memory address) and the slave is busy processing a transfer. Clock stretching is also used when a data byte has been transmitted, or received, to keep SCL low until a DMA operation has completed. In the transmit (AMBA read) case SCL is kept low before the rising edge of the first byte. In the receive case (AMBA write) the ACK cycle for the previous byte is stretched.

When clock stretching is disabled (NACK field is '1') the core will never stretch the SCL line. If the core is busy performing DMA when it is addressed, the address will not be acknowledged. If the core performs consecutive writes and the first write operation has not finished the core will now acknowledge the written byte. If the core performs a read operation and the read DMA operation has not finished when the core is supposed to deliver data then the core will go to its idle state and not respond to more accesses until a START condition is generated on the bus. This last part means that the NACK mode is practically unusable in systems where the AMBA access can take longer than one I<sup>2</sup>C clock period. This can be compensated by using a very slow I<sup>2</sup>C clock.

### 37.2.7 Memory protection

Default configuration allows full access to the complete AHB address range. The access range can be restricted via configuration registers.

The registers PADDR and PMASK are used to assign the memory protection area's address and mask in the following way

Before the core performs an AMBA access it will perform the check:

$$(((incoming\ address)\ xor\ (PADDR))\ and\ PMASK) \neq 0x00000000$$

If the above expression is true (one or several bits in the incoming address differ from the protection address, and the corresponding mask bits are set to '1') then the access is inhibited. As an example, assume that PADDR is 0xA0000000 and PMASK is 0xF0000000. Since PMASK only has ones in the most significant nibble, the check above can only be triggered for these bits. The address range of allowed accessed will thus be 0xA0000000 - 0xAFFFFFFF.

The core will set the configuration register bit PROT if an access is attempted outside the allowed address range. This bit is updated on each AHB access and will be cleared by an access inside the allowed range.

# LEON3FT Microcontroller

## 37.3 Registers

The core is programmed through registers mapped into APB address space.

Table 492. I<sup>2</sup>C slave registers

APB address offset	Register
0x00	Control register
0x04	Status register
0x08	Protection address register
0x0C	Protection mask register
0x10	I2C slave memory address register
0x14	I2C slave configuration address register

# LEON3FT Microcontroller

## 37.3.1 Control Register

Table 493.0x0 - CTRL - Control register

31	RESERVED	2	1	0
		IRQEN	EN	
	0	0	1	
	r	rw	rw	

- 31: 2      RESERVED
- 1          Interrupt enable (IRQEN) - When this bit is set to '1' the core will generate an interrupt each time the DMA field in the status register transitions from '0' to '1'.
- 0          Core enable (EN) - When this bit is set to '1' the core is enabled and will respond to I2C accesses. Otherwise the core will not react to I2C traffic.

## 37.3.2 Status Register

Table 494.0x04 - STAT - Status register

31	RESERVED	3	2	1	0
		PROT	WR	DMA	
	0x0	0	0	0	
	r	wc	r	wc	

- 31: 3      RESERVED
- 2          Protection triggered (PROT) - Full access is granted the I2C2AHB interface
- 1          Write access (WR) - Last AHB access performed was a write access. This bit is read only.
- 0          Direct Memory Access (DMA) - This bit gets set to '1' each time the core attempts to perform an AHB access. By setting the IRQEN field in the control register this condition can generate an interrupt. This bit can be cleared by software by writing '1' to this position.

## 37.3.3 Protection Address Register

Table 495.0x08 - PADDR - Protection address register

31	PROTADDR	0
	0x0	
	rw	

- 31 : 0      Protection address (PROTADDR) - Defines the base address for the memory area where the core is allowed to make accesses.

## 37.3.4 Protection Mask Register

Table 496.0x0C - PMASK - Protection mask register

31	PROTMASK	0
	0x0	
	rw	

- 31 : 0      Protection mask (PROTMASK) - Selects which bits in the Protection address register that are used to define the protected memory area.

# LEON3FT Microcontroller

## 37.3.5 I2C Slave Memory Address Register

Table 497. 0x10 - SLVADDR - I2C slave memory address register

31	7	6	0
RESERVED		I2CSLVADDR	
0		*	
r		rw	

31 : 7      RESERVED

6 : 0      I2C slave memory address (I2CSLVADDR) - Address that slave responds to for AHB memory accesses. The reset value is b101xxx0 where the three bits “xxx” are taken from the node ID bootstrap pins (GPIO[15] & GPIO[62] & GPIO[0]). See section 3.1 for more information.

## 37.3.6 I2C Slave Configuration Address Register

Table 498. 0x14 - SLVCFG - I2C slave configuration address register

31	7	6	0
RESERVED		I2CCFGADDR	
0		*	
r		rw	

31 : 7      RESERVED

6 : 0      I2C slave configuration address (I2CCFGADDR) - Address that slave responds to for configuration register accesses. The reset value is b101xxx1 where the three bits “xxx” are taken from the node ID bootstrap pins (GPIO[15] & GPIO[62] & GPIO[0]). See section 3.1 for more information.

# LEON3FT Microcontroller

## 38 I<sup>2</sup>C master

The LEON3FT microcontroller comprises two separate I<sup>2</sup>C master (I2CMST) units. Each I<sup>2</sup>C master unit controls its own external pins and has a unique AMBA address described in chapter 2.10.

The I<sup>2</sup>C master units are located on the APB bus in the address range from 0x8030E000 to 0x8030FFFF. See I<sup>2</sup>C master units connections in the next drawing. The figure shows memory locations and functions used for I<sup>2</sup>C master configuration and control.

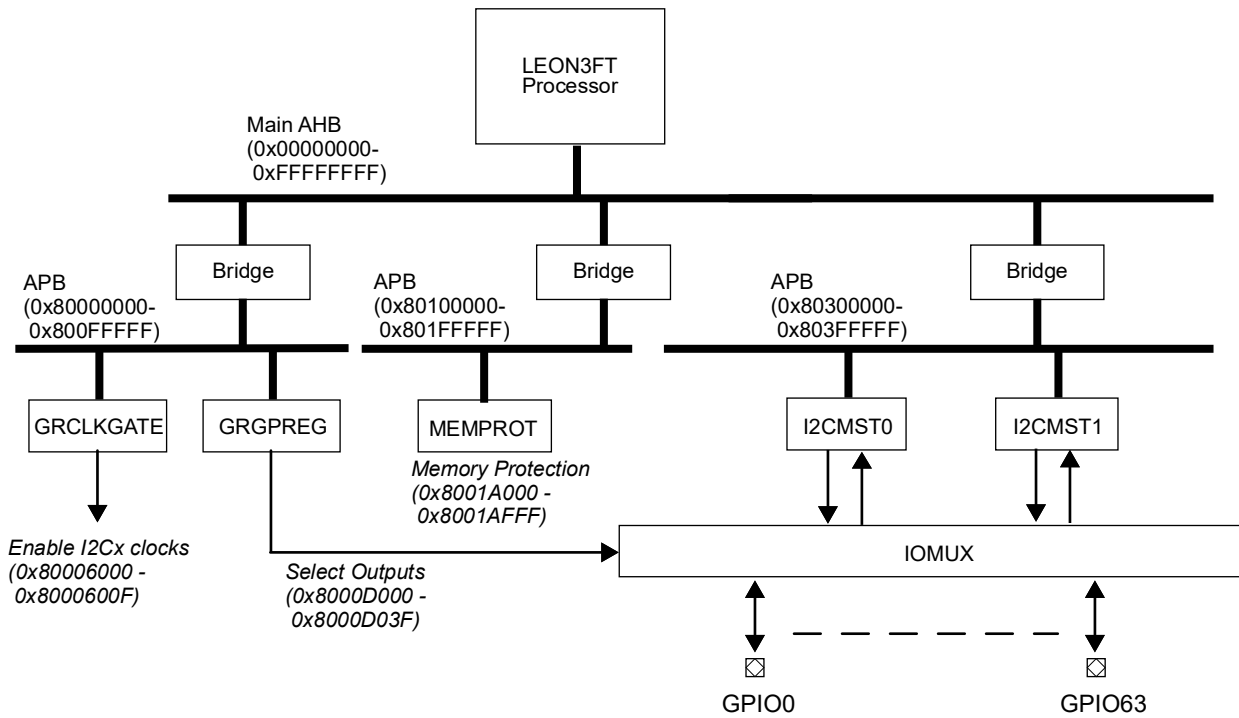


Figure 71. GR716 I<sup>2</sup>C-master bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable individual I<sup>2</sup>C master units. The unit **GRCLKGATE** can also be used to perform reset of individual I<sup>2</sup>C master units. Software must enable clock and release reset described in section 27 before I<sup>2</sup>C master configuration and transmission can start.

External IO selection per I<sup>2</sup>C master unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

Each **I2CMSTx** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. I2CMST unit 0 and 1 have identical configuration and status registers. Configuration and status registers are described in section 38.3.

The system can be configured to protect and restrict access to individual I<sup>2</sup>C-master unit in the **MEMPROT** unit. See section 47 for more information.

### 38.1 Overview

The I<sup>2</sup>C-master core is a modified version of the OpenCores I<sup>2</sup>C-Master with an AMBA APB interface. The core is compatible with Philips I<sup>2</sup>C standard and supports 7- and 10-bit addressing. Stan-

# LEON3FT Microcontroller

Standard-mode (100 kb/s) and Fast-mode (400 kb/s) operation are supported directly. External pull-up resistors must be supplied for both bus lines.

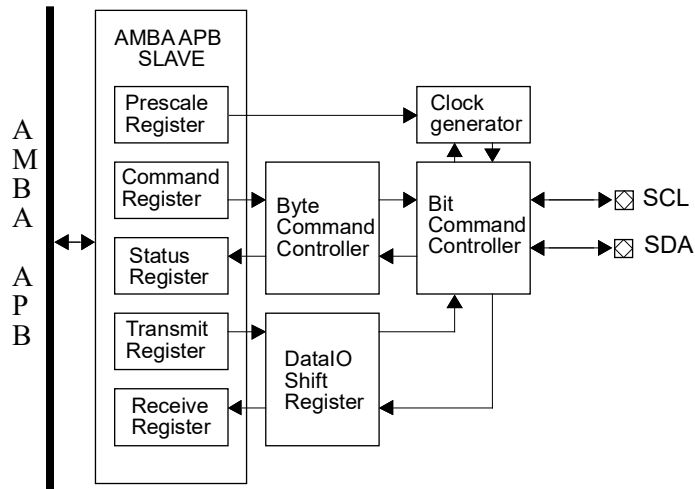


Figure 72. Block diagram

## 38.2 Operation

### 38.2.1 Transmission protocol

The I<sup>2</sup>C-bus is a simple 2-wire serial multi-master bus with collision detection and arbitration. The bus consists of a serial data line (SDA) and a serial clock line (SCL). The I<sup>2</sup>C standard defines three transmission speeds; Standard (100 kb/s), Fast (400 kb/s) and High speed (3.4 Mb/s).

A transfer on the I<sup>2</sup>C-bus begins with a START condition. A START condition is defined as a high to low transition of the SDA line while SCL is high. Transfers end with a STOP condition, defined as a low to high transition of the SDA line while SCL is high. These conditions are always generated by a master. The bus is considered to be busy after the START condition and is free after a certain amount of time following a STOP condition. The bus free time required between a STOP and a START condition is defined in the I<sup>2</sup>C-bus specification and is dependent on the bus bit rate.

Figure 73 shows a data transfer taking place over the I<sup>2</sup>C-bus. The master first generates a START condition and then transmits the 7-bit slave address. The bit following the slave address is the R/W bit which determines the direction of the data transfer. In this case the R/W bit is zero indicating a write operation. After the master has transmitted the address and the R/W bit it releases the SDA line. The receiver pulls the SDA line low to acknowledge the transfer. If the receiver does not acknowledge the transfer, the master may generate a STOP condition to abort the transfer or start a new transfer by generating a repeated START condition.

After the first byte has been acknowledged the master transmits the data byte. If the R/W bit had been set to '1' the master would have acted as a receiver during this phase of the transfer. After the data byte has been transferred the receiver acknowledges the byte and the master generates a STOP condition to complete the transfer. Section 38.2.3 contains three more example transfers from the perspective of a software driver.

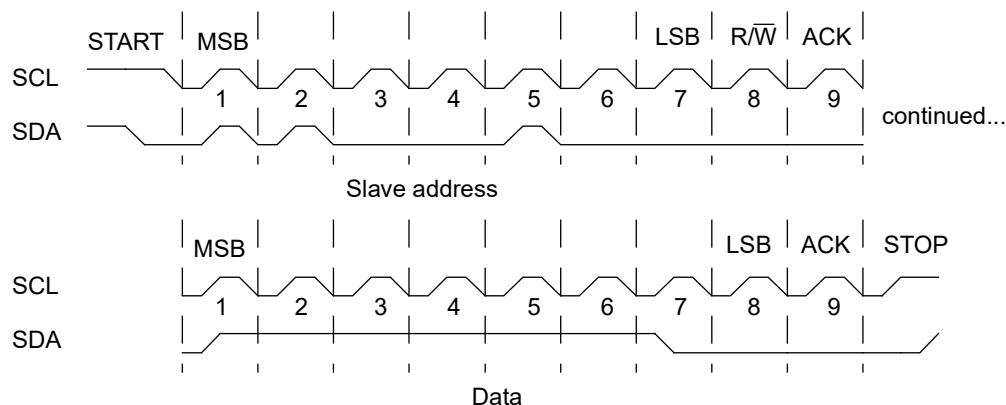


Figure 73. Complete I<sup>2</sup>C data transfer

If the data bitrate is too high for a slave device, it may stretch the clock period by keeping SCL low after the master has driven SCL low.

### 38.2.2 Clock generation

The core uses the prescale register to determine the frequency of the SCL clock line and of the 5\*SCL clock that the core uses internally. To calculate the prescale value use the formula:

$$Prescale = \frac{AMBA\text{clockfrequency}}{5 \cdot SCL\text{frequency}} - 1$$

The *SCLfrequency* is 100 kHz for Standard-mode operation (100 kb/s) and 400 kHz for Fast mode operation. To use the core in Standard-mode in a system with a 60 MHz clock driving the AMBA bus the required prescale value is:

$$Prescale = \frac{60\text{Mhz}}{5 \cdot 100\text{kHz}} - 1 = 119 = 0x77$$

Note that the prescale register should only be changed when the core is disabled. The minimum recommended prescale value is 3 due to synchronization issues. This limits the minimum system frequency to 2 MHz for operation in Standard-mode (to be able to generate a 100 kHz SCL clock). However, a system frequency of 2 MHz will not allow the implementation fulfill the 100 ns minimum requirement for data setup time (required for Fast-mode operation). For compatibility with the I<sup>2</sup>C Specification, in terms of minimum required data setup time, the minimum allowed system frequency is 20 MHz due to synchronization issues. If the core is run at lower system frequencies, care should be taken so that data from devices is stable on the bus one system clock period before the rising edge of SCL.

### 38.2.3 Software operational model

The core is initialized by writing an appropriate value to the clock prescale register and then setting the enable (EN) bit in the control register. Interrupts are enabled via the interrupt enable (IEN) bit in the control register.

To write a byte to a slave the I<sup>2</sup>C-master must generate a START condition and send the slave address with the R/W bit set to '0'. After the slave has acknowledged the address, the master transmits the



# LEON3FT Microcontroller

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data, waits for an acknowledge and generates a STOP condition. The sequence below instructs the core to perform a write:

1. Left-shift the I<sup>2</sup>C-device address one position and write the result to the transmit register. The least significant bit of the transmit register (R/W) is set to '0'.
2. Generate START condition and send contents of transmit register by setting the STA and WR bits in the command register.
3. Wait for interrupt, or for TIP bit in the status register to go low.
4. Read RxACK bit in status register. If RxACK is low the slave has acknowledged the transfer, proceed to step 5. If RxACK is set the device did not acknowledge the transfer, go to step 1.
5. Write the slave-data to the transmit register.
6. Send the data to the slave and generate a stop condition by setting STO and WR in the command register.
7. Wait for interrupt, or for TIP bit in the status register to go low.
8. Verify that the slave has acknowledged the data by reading the RxACK bit in the status register. RxACK should not be set.

To read a byte from an I<sup>2</sup>C-connected memory much of the sequence above is repeated. The data written in this case is the memory location on the I<sup>2</sup>C slave. After the address has been written the master generates a repeated START condition and reads the data from the slave. The sequence that software should perform to read from a memory device:

1. Left-shift the I<sup>2</sup>C-device address one position and write the result to the transmit register. The least significant bit of the transmit register (R/W) is set to '0'.
2. Generate START condition and send contents of transmit register by setting the STA and WR bits in the command register.
3. Wait for interrupt or for TIP bit in the status register to go low.
4. Read RxACK bit in status register. If RxACK is low the slave has acknowledged the transfer, proceed to step 5. If RxACK is set the device did not acknowledge the transfer, go to step 1.
5. Write the memory location to be read from the slave to the transmit register.
6. Set the WR bit in the command register. Note that a STOP condition is not generated here.
7. Wait for interrupt, or for TIP bit in the status register to go low.
8. Read RxACK bit in the status register. RxACK should be low.
9. Address the I<sup>2</sup>C-slave again by writing its left-shifted address into the transmit register. Set the least significant bit of the transmit register (R/W) to '1' to read from the slave.
10. Set the STA and WR bits in the command register to generate a repeated START condition.
11. Wait for interrupt, or for TIP bit in the status register to go low.
12. Read RxACK bit in the status register. The slave should acknowledge the transfer.
13. Prepare to receive the data read from the I<sup>2</sup>C-connected memory. Set bits RD, ACK and STO on the command register. Setting the ACK bit NAKs the received data and signifies the end of the transfer.
14. Wait for interrupt, or for TIP in the status register to go low.
15. The received data can now be read from the receive register.

To perform sequential reads the master can iterate over steps 13 - 15 by not setting the ACK and STO bits in step 13. To end the sequential reads the ACK and STO bits are set. Consult the documentation of the I<sup>2</sup>C-slave to see if sequential reads are supported.

# LEON3FT Microcontroller

The final sequence illustrates how to write one byte to an I<sup>2</sup>C-slave which requires addressing. First the slave is addressed and the memory location on the slave is transmitted. After the slave has acknowledged the memory location the data to be written is transmitted without a generating a new START condition:

1. Left-shift the I<sup>2</sup>C-device address one position and write the result to the transmit register. The least significant bit of the transmit register (R/W) is set to '0'.
2. Generate START condition and send contents of transmit register by setting the STA and WR bits in the command register.
3. Wait for interrupt or for TIP bit in the status register to go low.
4. Read RxACK bit in status register. If RxACK is low the slave has acknowledged the transfer, proceed to step 5. If RxACK is set the device did not acknowledge the transfer, go to step 1.
5. Write the memory location to be written from the slave to the transmit register.
6. Set the WR bit in the command register.
7. Wait for interrupt, or for TIP bit in the status register to go low.
8. Read RxACK bit in the status register. RxACK should be low.
9. Write the data byte to the transmit register.
10. Set WR and STO in the command register to send the data byte and then generate a STOP condition.
11. Wait for interrupt, or for TIP bit in the status register to go low.
12. Check RxACK bit in the status register. If the write succeeded the slave should acknowledge the data byte transfer.

The example sequences presented here can be generally applied to I<sup>2</sup>C-slaves. However, some devices may deviate from the protocol above, please consult the documentation of the I<sup>2</sup>C-slave in question. Note that a software driver should also monitor the arbitration lost (AL) bit in the status register.

## 38.3 Registers

The core is programmed through registers mapped into APB address space.

Table 499. I<sup>2</sup>C-master registers

APB address offset	Register
0x00	Clock prescale register
0x04	Control register
0x08	Transmit register*
0x08	Receive register**
0x0C	Command register*
0x0C	Status register**
0x10	Dynamic filter register

\* Write only

\*\* Read only

# LEON3FT Microcontroller

## 38.3.1 I<sup>2</sup>C-Master Clock Prescale Register

Table 500.0x00 - PRESCALE - I<sup>2</sup>C-master Clock prescale register

31	16	15	0
RESERVED		Clock prescale	
0		0xFFFF	
r		rw	

31 : 16 RESERVED

15:0 Clock prescale - Value is used to prescale the SCL clock line. Do not change the value of this register unless the EN field of the control register is set to '0'. The minimum recommended value of this register is 0x0003. Lower values may cause the master to violate I<sup>2</sup>C timing requirements due to synchronization issues.

## 38.3.2 I<sup>2</sup>C-Master Control Register

Table 501.0x04 - CTRL - I<sup>2</sup>C-master control register

31	8	7	6	5	0	
RESERVED				EN	IEN	RESERVED
0				0	0	0
r				rw	rw	r

31 : 8 RESERVED

7 Enable (EN) - Enable I<sup>2</sup>C core. The core is enabled when this bit is set to '1'.

6 Interrupt enable (IEN) - When this bit is set to '1' the core will generate interrupts upon transfer completion.

5:0 RESERVED

## 38.3.3 I<sup>2</sup>C-Master Transmit Register

Table 502.0x08 - TX - I<sup>2</sup>C-master transmit register

31	8	7	1	0
RESERVED			TDATA	RW
0			0	0
-			w	w

31 : 8 RESERVED

7:1 Transmit data (TDATA) - Most significant bits of next byte to transmit via I<sup>2</sup>C

0 Read/Write (RW) - In a data transfer this is the data's least significant bit. In a slave address transfer this is the RW bit. '1' reads from the slave and '0' writes to the slave.

## 38.3.4 I<sup>2</sup>C-Master Receive Register

Table 503.0x08 - RX - I<sup>2</sup>C-master receive register

31	8	7	0
RESERVED		RDATA	
		0	
		r	

31 : 8 RESERVED

7:0 Receive data (RDATA) - Last byte received over I<sup>2</sup>C-bus.

# LEON3FT Microcontroller

## 38.3.5 I<sup>2</sup>C-Master Command Register

Table 504.0x0C -CMD - I<sup>2</sup>C-master command register

31	8	7	6	5	4	3	2	1	0
RESERVED		STA	STO	RD	WR	ACK	RESERVED	IACK	
0		0	0	0	0	0	0	0	0
r		w*	w*	w*	w*	w*	r	-	

- 31 : 8      RESERVED
- 7          Start (STA) - Generate START condition on I<sup>2</sup>C-bus. This bit is also used to generate repeated START conditions.
- 6          Stop (STO) - Generate STOP condition
- 5          Read (RD) - Read from slave
- 4          Write (WR) - Write to slave
- 3          Acknowledge (ACK) - Used when acting as a receiver. '0' sends an ACK, '1' sends a NACK.
- 2:1        RESERVED
- 0          Interrupt acknowledge (IACK) - Clears interrupt flag (IF) in status register.

## 38.3.6 I<sup>2</sup>C-Master Status Register

Table 505.0x0C - STAT - I<sup>2</sup>C-master status register

31	8	7	6	5	4	3	2	1	0
RESERVED		RxACK	BUSY	AL	RESERVED		TIP	IF	
0		0	0	0	0		0	0	0
r		r	r	r	r		r	wc	

- 31 : 8      RESERVED
- 7          Receive acknowledge (RxACK) - Received acknowledge from slave. '1' when no acknowledge is received, '0' when slave has acked the transfer.
- 6          I<sup>2</sup>C-bus busy (BUSY) - This bit is set to '1' when a start signal is detected and reset to '0' when a stop signal is detected.
- 5          Arbitration lost (AL) - Set to '1' when the core has lost arbitration. This happens when a stop signal is detected but not requested or when the master drives SDA high but SDA is low.
- 4:2        RESERVED
- 1          Transfer in progress (TIP) - '1' when transferring data and '0' when the transfer is complete. This bit is also set when the core will generate a STOP condition.
- 0          Interrupt flag (IF) - This bit is set when a byte transfer has been completed and when arbitration is lost. If IEN in the control register is set an interrupt will be generated. New interrupts will be generated even if this bit has not been cleared.

## 38.3.7 I<sup>2</sup>C-Master Dynamic Filter Register

Table 506.0x10 - FILT - I<sup>2</sup>C-master dynamic filter register

31	2	1	0
RESERVED		FILT	
0		0x3	
r		rw	

- 31 : 2      RESERVED
- 1 : 0      Dynamic filter reload value (FILT) - This field sets the reload value for the dynamic filter counter. The core will ignore all pulses on the bus shorter than 2 \* (system clock period) and may also ignore pulses shorter than 2 \* 2 \* (system clock period) - 1.

# LEON3FT Microcontroller

## 39 I<sup>2</sup>C slave

The LEON3FT microcontroller comprises two separate I<sup>2</sup>C slave (I2CSLV) units. Each I<sup>2</sup>C slave unit controls its own external pins and has a unique AMBA address described in chapter 2.10.

The I<sup>2</sup>C slave units are located on the APB bus in the address range from 0x8040C000 to 0x8040DFFF. See I<sup>2</sup>C slave units connections in the next drawing. The figure shows memory locations and functions used for I<sup>2</sup>C slave configuration and control.

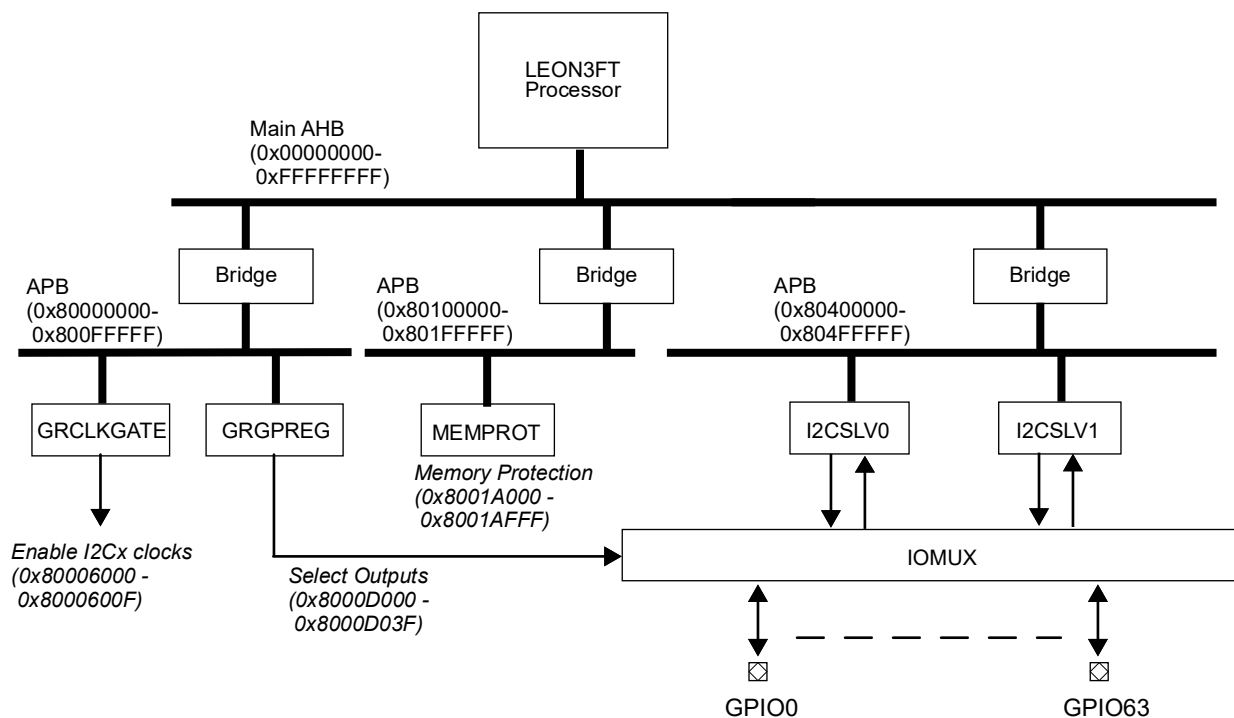


Figure 74. GR716 I<sup>2</sup>C-slave bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable individual I<sup>2</sup>C slave units. The unit **GRCLKGATE** can also be used to perform reset of individual I<sup>2</sup>C slave units. Software must enable clock and release reset described in section 27 before I<sup>2</sup>C slave configuration and transmission can start.

External IO selection per I<sup>2</sup>C slave unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

Each **I2CSLVx** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. I2CSLV unit 0 and 1 has identical configuration and status registers. Configuration and status registers are described in section 39.3.

System can be configured to protect and restrict access to individual I<sup>2</sup>C slave unit in the **MEMPROT** unit. See section 47 for more information.

### 39.1 Overview

The I<sup>2</sup>C slave core is a simple I<sup>2</sup>C slave that provides a link between the I<sup>2</sup>C bus and the AMBA APB. The core is compatible with Philips I<sup>2</sup>C standard and supports 7- and 10-bit addressing with an optionally software programmable address. Standard-mode (100 kb/s) and Fast-mode (400 kb/s) operation are supported directly. External pull-up resistors must be supplied for both bus lines.

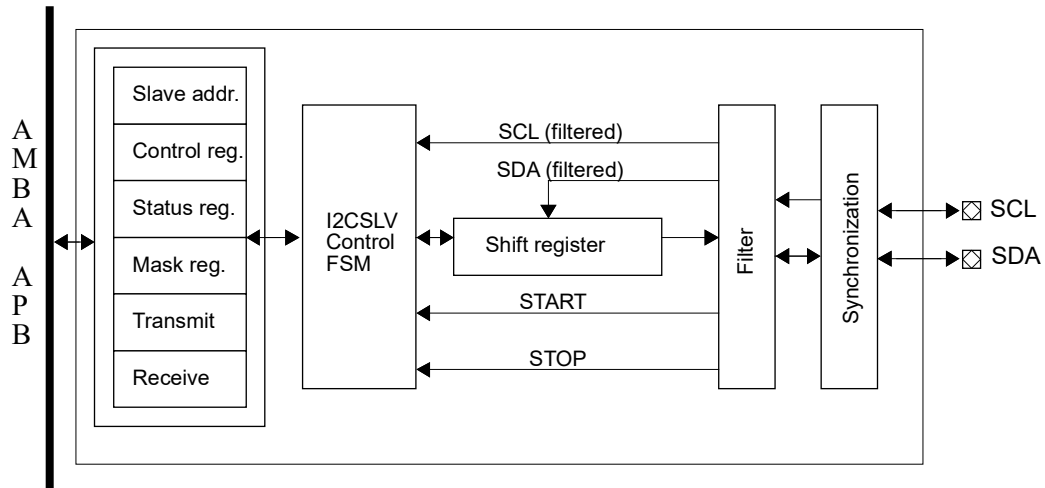


Figure 75. Block diagram

## 39.2 Operation

### 39.2.1 Transmission protocol

The I<sup>2</sup>C-bus is a simple 2-wire serial multi-master bus with collision detection and arbitration. The bus consists of a serial data line (SDA) and a serial clock line (SCL). The I<sup>2</sup>C standard defines three transmission speeds; Standard (100 kb/s), Fast (400 kb/s) and High speed (3.4 Mb/s).

A transfer on the I<sup>2</sup>C-bus begins with a START condition. A START condition is defined as a high to low transition of the SDA line while SCL is high. Transfers end with a STOP condition, defined as a low to high transition of the SDA line while SCL is high. These conditions are always generated by a master. The bus is considered to be busy after the START condition and is free after a certain amount of time following a STOP condition. The bus free time required between a STOP and a START condition is defined in the I<sup>2</sup>C-bus specification and is dependent on the bus bit rate.

Figure 76 shows a data transfer taking place over the I<sup>2</sup>C-bus. The master first generates a START condition and then transmits the 7-bit slave address. I<sup>2</sup>C also supports 10-bit addresses, which are discussed briefly below. The bit following the slave address is the R/ $\overline{W}$  bit which determines the direction of the data transfer. In this case the R/ $\overline{W}$  bit is zero indicating a write operation. After the master has transmitted the address and the R/ $\overline{W}$  bit it releases the SDA line. The receiver pulls the SDA line low to acknowledge the transfer. If the receiver does not acknowledge the transfer, the master may generate a STOP condition to abort the transfer or start a new transfer by generating a repeated START condition.

After the address has been acknowledged the master transmits the data byte. If the R/ $\overline{W}$  bit had been set to '1' the master would have acted as a receiver during this phase of the transfer. After the data byte has been transferred the receiver acknowledges the byte and the master generates a STOP condition to complete the transfer.

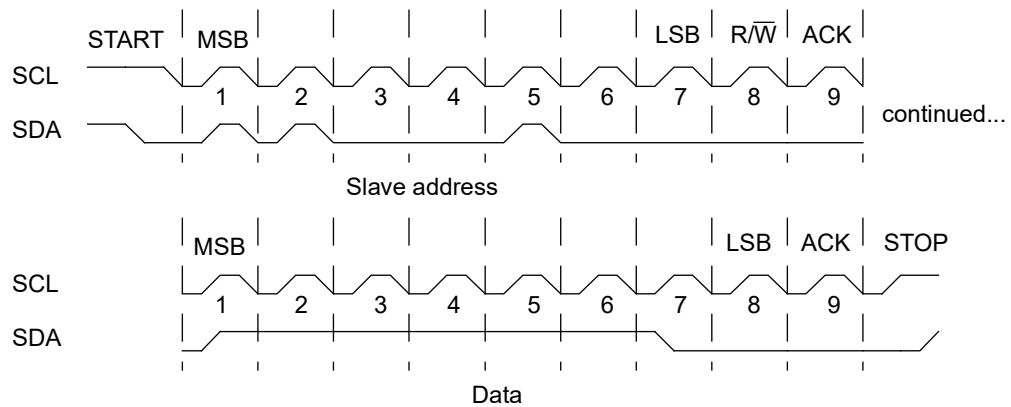


Figure 76. Complete I<sup>2</sup>C data transfer

An I<sup>2</sup>C slave may also support 10-bit addressing. In this case the master first transmits a pattern of five reserved bits followed by the two first bits of the 10-bit address and the R/W bit set to '0'. The next byte contains the remaining bits of the 10-bit address. If the transfer is a write operation the master then transmits data to the slave. To perform a read operation the master generates a repeated START condition and repeats the first part of the 10-bit address phase with the R/W bit set to '1'.

If the data bitrate is too high for a slave device or if the slave needs time to process data, it may stretch the clock period by keeping SCL low after the master has driven SCL low.

### 39.2.2 Slave addressing

The core have a programmable address and support for 7-bit and 10-bit addresses. The core is configured to use 10-bit address as default. The address mode controlled with the TBA bit in the Slave address register.

### 39.2.3 System clock requirements and sampling

The core samples the incoming I<sup>2</sup>C SCL clock and does not introduce any additional clock domains into the system. Both the SCL and SDA lines first pass through two stage synchronizers and are then filtered with a low pass filter consisting of four registers.

START and STOP conditions are detected if the SDA line, while SCL is high, is at one value for two system clock cycles, toggles and keeps the new level for two system clock cycles.

The synchronizers and filters constrain the minimum system frequency. The core requires the SCL signal to be stable for at least four system clock cycles before the core accepts the SCL value as the new clock value. The core's reaction to transitions will be additionally delayed since both lines are taken through two-stage synchronizers before they are filtered. Therefore it takes the core over eight system clock cycles to discover a transition on SCL. To use the slave in Standard-mode operation at 100 kHz the recommended minimum system frequency is 2 MHz. For Fast-mode operation at 400 kHz the recommended minimum system frequency is 6 MHz.

### 39.2.4 Operational model

The core has four main modes of operation and is configured to use one of these modes via the Control register bits Receive Mode (RMOD) and Transmit Mode (TMOD). The mode setting controls the core's behavior after a byte has been received or transmitted.

The core will always NAK a received byte if the receive register is full when the whole byte is received. If the receive register is free the value of RMOD determines if the core should continue to listen to the bus for the master's next action or if the core should drive SCL low to force the master

# LEON3FT Microcontroller

into a wait state. If the value of the RMOD field is ‘0’ the core will listen for the master’s next action. If the value of the RMOD field is ‘1’ the core will drive SCL low until the Receive register has been read and the Status register bit Byte Received (REC) has been cleared. Note that the core has not accepted a byte if it does not acknowledge the byte.

When the core receives a read request it evaluates the Transmit Valid (TV) bit in the Control register. If the Transmit Valid bit is set the core will acknowledge the address and proceed to transmit the data held in the Transmit register. After a byte has been transmitted the core assigns the value of the Control register bit Transmit Always Valid (TAV) to the Transmit Valid (TV) bit. This mechanism allows the same byte to be sent on all read requests without software intervention. The value of the Transmit Mode (TMOD) bit determines how the core acts after a byte has been transmitted and the master has acknowledged the byte, if the master NAKs the transmitted byte the transfer has ended and the core goes into an idle state. If TMOD is set to ‘0’ when the master acknowledges a byte the core will continue to listen to the bus and wait for the master’s next action. If the master continues with a sequential read operation the core will respond to all subsequent requests with the byte located in the Transmit Register. If TMOD is ‘1’ the core will drive SCL low after a master has acknowledged the transmitted byte. SCL will be driven low until the Transmit Valid bit in the control register is set to ‘1’. Note that if the Transmit Always Valid (TAV) bit is set to ‘1’ the Transmit Valid bit will immediately be set and the core will have show the same behavior for both Transmit modes.

When operating in Receive or Transmit Mode ‘1’, the bus will be blocked by the core until software has acknowledged the transmitted or received byte. This may have a negative impact on bus performance and it also affects single byte transfers since the master is prevented to generate STOP or repeated START conditions when SCL is driven low by the core.

The core reports three types of events via the Status register. When the core NAKs a received byte, or its address in a read transfer, the NAK bit in the Status register will be set. When a byte is successfully received the core asserts the Byte Received (REC) bit. After transmission of a byte, the Byte Transmitted (TRA) bit is asserted. These three bits can be used as interrupt sources by setting the corresponding bits in the Mask register.

## 39.3 Registers

The core is programmed through registers mapped into APB address space.

Table 507.1<sup>2</sup>C slave registers

APB address offset	Register
0x00	Slave address register
0x04	Control register
0x08	Status register
0x0C	Mask register
0x10	Receive register
0x14	Transmit register



# LEON3FT Microcontroller

## 39.3.1 Slave Address Register

Table 508.0x00 - SLVADDR - Slave address register

31	30	10	9	0
TBA	RESERVED			SLVADDR
1	0			0x50
rw	r			rw

- 31 Ten-bit Address (TBA) - When this bit is set the core will interpret the value in the SLVADDR field as a 10-bit address.
- 30 : 10 RESERVED
- 9:0 Slave address (SLVADDR) - Contains the slave I2C address.

## 39.3.2 Control Register

Table 509.0x04 - CTRL - Control register

31	5	4	3	2	1	0		
RESERVED				RMOD	TMOD	TV	TAV	EN
0				NR	NR	NR	NR	NR
r				rw	rw	rw	rw	rw

- 31 : 5 RESERVED
- 4 Receive Mode (RMOD) - Selects how the core handles writes:
  - '0': The slave accepts one byte and NAKs all other transfers until software has acknowledged the received byte by reading the Receive register.
  - '1': The slave accepts one byte and keeps SCL low until software has acknowledged the received byte by reading the Receive register.
- 3 Transmit Mode (TMOD) - Selects how the core handles reads:
  - '0': The slave transmits the same byte to all if the master requests more than one byte in the transfer. The slave then NAKs all read requests as long as the Transmit Valid (TV) bit is unset.
  - '1': The slave transmits one byte and then keeps SCL low until software has acknowledged that the byte has been transmitted by setting the Transmit Valid (TV) bit.
- 2 Transmit Valid (TV) - Software sets this bit to indicate that the data in the transmit register is valid. The core automatically resets this bit when the byte has been transmitted. When this bit is '0' the core will either NAK or insert wait states on incoming read requests, depending on the Transmit Mode (TMOD).
- 1 Transmit Always Valid (TAV) - When this bit is set, the core will not clear the Transmit Valid (TV) bit when a byte has been transmitted.
- 0 Enable core (EN) - Enables core. When this bit is set to '1' the core will react to requests to the address set in the Slave address register. If this bit is '0' the core will keep both SCL and SDA inputs in Hi-Z state.

# LEON3FT Microcontroller

## 39.3.3 Status Register

Table 510.0x08 - STAT - Status register

31	RESERVED	3	2	1	0
		REC	TRA	NAK	
	0	0	0	0	
	r	*	wc	wc	

- 31 : 3      RESERVED
- 2          Byte Received (REC) - This bit is set to '1' when the core accepts a byte and is automatically cleared when the Receive register has been read.
- 1          Byte Transmitted (TRA) - This bit is set to '1' when the core has transmitted a byte and is cleared by writing '1' to this position. Writes of '0' have no effect.
- 0          NAK Response (NAK) - This bit is set to '1' when the core has responded with NAK to a read or write request. This bit does not get set to '1' when the core responds with a NAK to an address that does not match the cores address. This bit is cleared by writing '1' to this position, writes of '0' have no effect.

## 39.3.4 Mask Register

Table 511.0x0C - MASK - Mask register

31	RESERVED	3	2	1	0
		RECE	TRAE	NAKE	
	0	0	0	0	
	r	rw	rw	rw	

- 31 : 3      RESERVED
- 2          Byte Received Enable (RECE) - When this bit is set the core will generate an interrupt when bit 2 in the Status register gets set.
- 1          Byte Transmitted Enable (TRAE) - When this bit is set the core will generate an interrupt when bit 1 in the Status register gets set.
- 0          NAK Response Enable (NAKE) - When this bit is set the core will generate an interrupt when bit 0 in the Status register gets set.

## 39.3.5 Receive Register

Table 512.0x10 - RX - Receive register

31	RESERVED	8	7	0
		RECBYTE		
	0	NR		
	r	r		

- 31 : 8      RESERVED
- 7:0        Received Byte (RECBYTE) - Last byte received from master. This field only contains valid data if the Byte received (REC) bit in the status register has been set.

# LEON3FT Microcontroller

## 39.3.6 Transmit Register

Table 513.0x14 - TX - Transmit register

31	8	8	7	0
RESERVED			TRABYTE	
0			NR	
r			rw	

31 : 8      RESERVED

7:0      Transmit Byte (TRABYTE) - Byte to transmit on the next master read request.

Reset value: Undefined

# LEON3FT Microcontroller

## 40 Interrupt Controller

The LEON3FT microcontroller have one Interrupt controller (IRQAMP). The Interrupt controller (IRQAMP) have a unique AMBA base address described in chapter 2.10.

The Interrupt controller (IRQAMP) is located on APB bus in the address range from 0x80002000 to 0x80002FFF. See the Interrupt controller (IRQAMP) control and status interface connection in next drawing. The drawing picture memory locations and functions used for Interrupt controller (IRQAMP) configuration and control.

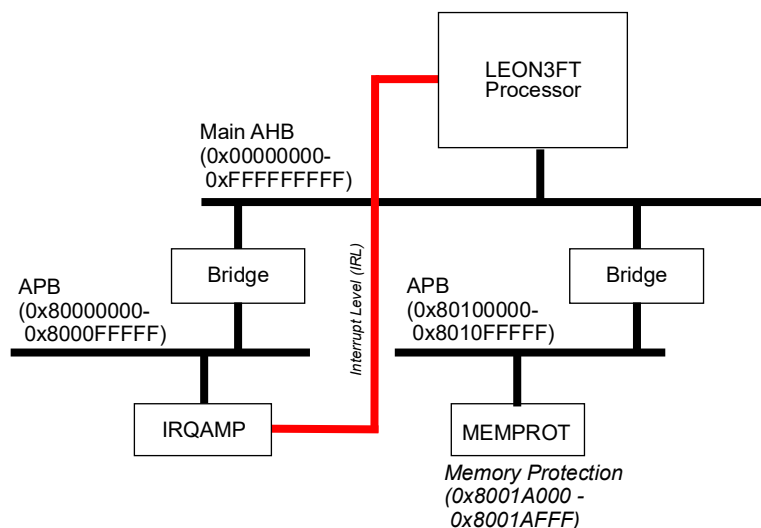


Figure 77. GR716 Interrupt controller bus connection

It is not possible to disable clock to the interrupt controller since the interrupt controller is used to wake-up the processor from deep-sleep i.e. when the clock to the processor is disabled.

The interrupt controllers configuration and status registers are describe in this section 40.3.

System can be configured to protect and restrict access to interrupt controller in the **MEMPROT** unit. For more information See section 47 for more information.

### 40.1 Overview

The LEON3FT microcontroller implements an interrupt scheme where interrupt lines are routed together with the remaining AHB/APB bus signals forming an interrupt bus. The interrupt controller core is attached to the AMBA bus as an APB slave and monitors the combined interrupt signals.

The interrupts generated on the interrupt bus are all forwarded to the interrupt controller. The interrupt controller prioritizes, masks and propagates the interrupt with the highest priority to the processor.

Interrupts from peripherals has been assigned a unique ID see chapter 2.12. The unique peripheral interrupt ID can be used for dynamically remapping of interrupts in the interrupt controller.

#### 40.1.1 Definition

This chapter defines and explains the interrupt terminology used in this chapter. In the following chapters the following terms will be used:

- Bus interrupt line
- Interrupt ID number
- Extended Interrupt number

# LEON3FT Microcontroller

The **bus interrupt line** is the actual hardware interrupt used by the peripheral. The term **bus** is used since the internal hardware interrupt lines are distributed via the system bus architecture. The **bus interrupt line** is in the range from 0 to 63

The **interrupt number** refers to the interrupt line handled by the interrupt controller i.e. values between 1 to 15. Any arbitrary **bus interrupt line** can be mapped to any arbitrary **interrupt number** from 2 to 15. **Interrupt number 1** has the lowest priority and is reserved for **Extended interrupt numbers**.

**Extended interrupt number** is arbitrary bus interrupt lines mapped to arbitrary numbers between 16 to 32. **Extended interrupt numbers** is grouped into one **interrupt number** i.e. all **extended interrupt numbers** have the same priority and **interrupt number**.

## 40.1.2 Structure

This is a picture of the system interrupt generation and remapping functionality available in the GR716 device.

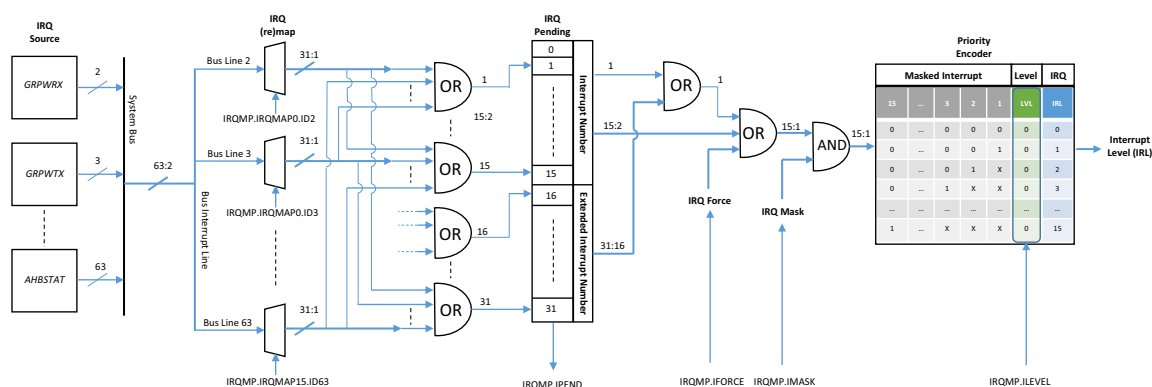


Figure 78. System and Interrupt controller block diagram

## 40.2 Operation

### 40.2.1 Interrupt prioritization

The interrupt controller monitors **interrupt number 1 - 15** and **extended interrupt number 16 - 32**. When any of these interrupts are asserted high, the corresponding bit in the interrupt pending register is set. The pending bits will stay set until cleared by software or by an interrupt acknowledge from the processor.

**Interrupt number 1 - 15** can be assigned to one of two levels (0 or 1) as programmed in the interrupt level register. Level 1 has higher priority than level 0. The interrupts are prioritised within each level, with interrupt 15 having the highest priority and interrupt 1 the lowest. The highest interrupt from level 1 will be forwarded to the processor. If no unmasked pending interrupt exists on level 1, then the highest unmasked interrupt from level 0 will be forwarded.

**Extended interrupt number 16 - 32** are grouped and OR:ed into **Interrupt number 1** depict in figure 78. **Extended interrupt number 16 - 32** has no level control and have no prioritization between individual interrupts.

When the LEON3FT processor acknowledges the interrupt, the corresponding pending bit will automatically be cleared. For **extended interrupt** the extended acknowledge register will identify which extended interrupt that was most recently acknowledged. This register can be used by software to invoke the appropriate interrupt handler for the extended interrupts.

# LEON3FT Microcontroller

Interrupt can also be forced by setting a bit in the interrupt force register. In this case, the processor acknowledgment will clear the force bit rather than the pending bit. After reset, the interrupt mask register is set to all zeros while the remaining control registers are undefined. Note that interrupt 15 cannot be maskable by the LEON3FT processor and should be used with care - most operating systems do not safely handle this interrupt.

## 40.2.2 Interrupt (re)map functionality

The LEON3FT microcontroller have 64 unique *bus interrupt line* sources listed in section 2.12, while the LEON3FT processor only supports 31 unique interrupt sources i.e. *interrupt ID number* 1 - 15 and *extended interrupt number* 16 - 32.

To accommodate all the 64 unique *bus interrupt line* sources the interrupt controller allow dynamic remapping between *bus interrupt lines* and any *interrupt ID number* 1 - 15 or any *extended interrupt number* 16 - 32. Individual remap logic on each incoming *bus interrupt line* will map the *bus interrupt line* sources to specified *interrupt ID number* 1 - 15 or *extended interrupt number* 16 - 32.

The Interrupt map registers is available starting at address 0x80002300 from the interrupt controller's base address. The interrupt map registers contain one field for each *bus interrupt line* in the system. The value within this field determines to which interrupt controller line the *bus interrupt line* is connected. In case several *bus interrupt lines* are mapped to the same *interrupt ID number* or *extended interrupt number* (several fields in the Interrupt map registers have the same value) then the *bus interrupt lines* will be OR:ed together.

Note that if *bus interrupt line X* is remapped to controller *interrupt ID number* 2 - 15 then corresponding bit in the range 2 - 15 of the pending register will be set when a peripheral asserts interrupt *bus interrupt line X*. Where, the *bus interrupt line X* is remapped to controller *extended interrupt number* 16 - 32 then corresponding bit in the range 16 - 32 and bit 1 of the pending register will be set when a peripheral asserts interrupt *bus interrupt line X*

## 40.2.3 Processor status monitoring

The processor status can be monitored through the Processor Status Register. The STATUS field in this register indicates if a processor is halted ('1') or running ('0'). A halted processor can be reset and restarted by writing a '1' to its status field.

The interrupt controller also supports setting the reset start address dynamically. Please see section 40.2.7 for further information.

## 40.2.4 Interrupt timestamping description

Interrupt timestamping is controlled via the Interrupt Timestamp Control register(s). Each Interrupt Timestamp Control register contains a field (TSTAMP) that contains the number of timestamp registers sets that the core implements. A timestamp register sets consist of one Interrupt Timestamp Counter register, one Interrupt Timestamp Control register, one Interrupt Assertion Timestamp register and one Interrupt Acknowledge Timestamp register.

Software enables timestamping for a specific interrupt via a Interrupt Timestamp Control Register. When the selected interrupt line is asserted, software will save the current value of the interrupt timestamp counter into the Interrupt Assertion Timestamp register and set the S1 field in the Interrupt Timestamp Control Register. When the processor acknowledges the interrupt, the S2 field of the Interrupt Timestamp Control register will be set and the current value of the timestamp counter will be saved in the Interrupt Acknowledge Timestamp Register. The difference between the Interrupt Assertion timestamp and the Interrupt Acknowledge timestamp is the number of system clock cycles that was required for the processor to react to the interrupt and divert execution to the trap handler.

The core can be configured to stamp only the first occurrence of an interrupt or to continuously stamp interrupts. The behavior is controlled via the Keep Stamp (KS) field in the Interrupt Timestamp Con-

# LEON3FT Microcontroller

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trol Register. If KS is set, only the first assertion and acknowledge of an interrupt is stamped. Software must then clear the S1 and S2 fields for a new timestamp to be taken. If Keep Stamp is disabled (KS field not set), the controller will update the Interrupt Assertion Timestamp Register every time the selected interrupt line is asserted. In this case the controller will also automatically clear the S2 field and also update the Interrupt Acknowledge Timestamp register with the current value when the interrupt is acknowledged.

## 40.2.5 Interrupt timestamping usage guidelines

Note that KS = '0' and a high interrupt rate may cause the Interrupt Assertion Timestamp register to be updated (and the S2 field reset) before the processor has acknowledged the first occurrence of the interrupt. When the processor then acknowledges the first occurrence, the Interrupt Acknowledge Timestamp register will be updated and the difference between the two Timestamp registers will not show how long it took the processor to react to the first interrupt request. If the interrupt frequency is expected to be high it is recommended to keep the first stamp (KS field set to '1') in order to get reliable measurements. KS = '0' should not be used in systems that include cores that use level interrupts, the timestamp logic will register each cycle that the interrupt line is asserted as an interrupt.

In order to measure the full interrupt handling latency in a system, software should also read the current value of the Interrupt Timestamp Counter when entering the interrupt handler. In the typical case, a software driver's interrupt handler reads a status register and then determines the action to take. Adding a read of the timestamp counter before this status register read can give an accurate view of the latency during interrupt handling.

The interrupt controller listens to the system interrupt vector when reacting to interrupt line assertions. This means that the Interrupt Assertion Timestamp Register(s) will not be updated if software writes directly to the pending or force registers. To measure the time required to serve a forced interrupt, read the value of the Interrupt Timestamp counter before forcing the interrupt and then read the Interrupt Acknowledge Timestamp and Interrupt Timestamp counter when the processor has reacted to the interrupt.

## 40.2.6 Watchdog

The interrupt controller supports for asserting a bit in the controller's Interrupt Pending Register when an external watchdog signal is asserted. This functionality can be used to implement a sort of soft watchdog for one or several processor cores. The controller's Watchdog Control Register contains a field that shows the number of external watchdog inputs supported and fields for configuring which watchdog inputs that should be able to assert a bit in the Interrupt Pending Register. The pending register will be assigned in each cycle that a selected watchdog input is high. Therefore it is recommended that the watchdog inputs are connected to sources which send a one clock cycle long pulse when a watchdog expires. Otherwise software should make sure that the watchdog signal is deasserted before re-enabling interrupts during interrupt handling.

The GR716 microcontroller supports soft watchdog events from GPTIMER0 timer 6 and GPTIMER0 timer 7.

## 40.2.7 Dynamic processor reset start address

The interrupt controller can be used to start processor execution from a specified start address. The interface provided to accomplish this is:

- Error mode status register
- Processor boot address registers

The register interface allows software to force a processor into debug or error mode. This means that the interface can be used to stop (and restart) a processor. Registers are available to allow starting a halted processor from an arbitrary 8 byte aligned entry point. The processor can be started with the

# LEON3FT Microcontroller

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same register write as when the entry point is written, or the processor can be started later using the regular processor status register bit.

An error register is also added to allow monitoring processors for error mode, and to allow forcing a specific processor into error mode. This can be used to monitor and re-boot processors without resetting the system.

## 40.2.8 Restart processor from internal on-chip memory

To restart the processor from on-chip instruction memory set the register PROCBOOT-ADR=0x31000001.

## 40.2.9 Restart processor from external SRAM memory

To restart the processor from on-chip instruction memory set the register PROCBOOT-ADR=0x40000001.



# LEON3FT Microcontroller

## 40.3 Registers

The core is controlled through registers mapped into APB address space.

Table 514. Interrupt Controller registers

APB address offset	Register
0x80002000	Interrupt level register
0x80002004	Interrupt pending register
0x80002008	Interrupt force register
0x8000200C	Interrupt clear register
0x80002010	Status register
0x80002014	Reserved
0x80002018	Error Mode status register
0x8000201C	Watchdog control register
0x80002020	Reserved
0x80002024	Reserved
0x80002028	Reserved
0x8000202C	Reserved
0x80002030	Reserved
0x80002034	Extended Interrupt Clear Register
0x80002038	Reserved
0x8000203C	Reserved
0x80002040	Processor interrupt mask register
0x80002080	Processor interrupt force register
0x800020C0	Processor extended interrupt acknowledge register
0x80002100	Interrupt timestamp 0 counter register
0x80002104	Interrupt timestamp 0 control register
0x80002108	Interrupt assertion timestamp 0 register
0x8000210C	Interrupt acknowledge timestamp 0 register
0x80002110	Interrupt timestamp 1 counter register (mirrored in each set)
0x80002114	Interrupt timestamp 1 control register
0x80002118	Interrupt assertion timestamp 1 register
0x8000211C	Interrupt acknowledge timestamp 1 register
0x80002120	Interrupt timestamp 2 counter register (mirrored in each set)
0x80002124	Interrupt timestamp 2 control register
0x80002128	Interrupt assertion timestamp 2 register
0x8000212C	Interrupt acknowledge timestamp 2 register
0x80002130	Interrupt timestamp 3 counter register (mirrored in each set)
0x80002134	Interrupt timestamp 3 control register
0x80002138	Interrupt assertion timestamp 3 register
0x8000213C	Interrupt acknowledge timestamp 3 register
0x80002200	Processor boot address register
0x80002300 + 0x4 * <i>m</i>	Interrupt map register <i>m</i>

\* Number of interrupts in LEON3FT microcontroller is 64 hence *m* is 16

# LEON3FT Microcontroller

## 40.3.1 Interrupt Level Register

Table 515. 0x80002000 - ILEVEL - Interrupt Level Register

31	RESERVED	16 15	IL[15:1]	1 0
	0		NR	0
	r		rw	r

31:16	Reserved
15:1	Interrupt Level n (IL[n]) - Interrupt level for interrupt n
0	Reserved

## 40.3.2 Interrupt Pending Register

Table 516. 0x80002004 - IPEND - Interrupt Pending Register

31	EIP[31:16]	16 15	IP[15:1]	1 0
	0		0	0
	rw		rw	r

31:16	Extended Interrupt Pending n (EIP[n])
15:1	Interrupt Pending n (IP[n]) - Interrupt pending for interrupt n
0	Reserved

## 40.3.3 Interrupt Force Register

Table 517. 0x80002008 - IFORCE0 - Interrupt Force Register

31	RESERVED	16 15	IF[15:1]	1 0
	0		0	0
	r		rw	r

31:16	Reserved
15:1	Interrupt Force n (IF[n]) - Force interrupt nr n.
0	Reserved

## 40.3.4 Interrupt Clear Register

Table 518. 0x8000200C - ICLEAR - Interrupt Clear Register

31	EIC[31:16]	16 15	IC[15:1]	1 0
	0		0	0
	w		w	r

31:16	Extended Interrupt Clear n (EIC[n])
15:1	Interrupt Clear n (IC[n]) - Writing '1' to IC[n] will clear interrupt n
0	Reserved

# LEON3FT Microcontroller

## 40.3.5 Status Register

Table 519. 0x80002010 - MPSTAT - Status Register

31	20 19	16 15	1 0
RESERVED	EIRQ		STATUS
0	1	0	*
r	r	r	rw

- 31:20 Reserved
- 19:16 Extended IRQ (EIRQ) - Interrupt number 1 used for extended interrupts.
- 15:1 Reserved
- 0 Power-down status of CPU (STATUS) - 0x1 = power-down, 0x0 = running. Write STATUS with 0x1 to start processor.

## 40.3.6 Error Mode Status Register

Table 520. 0x80002018 - ERRSTAT - Error Mode Status Register

31	RESERVED	1 0
	0	EM
	r	rw

- 31:1 Reserved
- 0 Error Mode register (EM) - Read operation of register shows the error mode of the LEON3FT processor (1 = 'error mode', '0' = debug/run/power-down). Write to register will force LEON3FT processor into error mode.

## 40.3.7 Watchdog Control Register

Table 521. 0x8000201C - WDOGCTRL - Watchdog Control Register

31	27 26	20 19	16 15	0
NWDOG	Reserved	WDOGIRQ	WDOGMSK	
2	0	NR	0	
r	r	rw	rw	

- 31:27 Number of watchdog inputs (NWDOG) - Number of watchdog inputs that the core supports.
  - 26:20 Reserved
  - 19:16 Watchdog interrupt (WDOGIRQ) - Selects the bit in the pending register to set when any line watchdog line selected by the WDOGMSK field is asserted.
  - 15:0 Watchdog Mask n (WDOGMSK[n]) - If WDOGMSK[n] = '1' then the assertion of watchdog input n will lead to the bit selected by the WDOGIRQ field being set in the controller's Interrupt Pending Register.
- Configurable soft watchdog inputs:
- Bit #0 - Enable soft watchdog for GPTIMER0 timer 7
  - Bit #1 - Enable soft watchdog for GPTIMER0 timer 6
  - Bit #2 to Bit #15 are unused

# LEON3FT Microcontroller

## 40.3.8 Processor Interrupt Mask Register

Table 522. 0x80002040 - PIMASK - Processor Interrupt Mask Register

31		16	15		1	0
EIM[31:16]			IM15:1]			R
0			0			0
rw			rw			r

- 31:16 Extended Interrupt Mask n (EIC[n]) - Interrupt mask for extended interrupts
- 15:1 Interrupt Mask n (IM[n]) - If IM[n] = '0' then interrupt n is masked, otherwise it is enabled.
- 0 Reserved

## 40.3.9 Processor Interrupt Force Register

Table 523. 0x80002080 - PCFORCE - Processor Interrupt Force Register

31		17	16	15		1	0
IFC[15:1]			R	IF15:1]			R
0			0	0			0
wc			r	rw*			r

- 31:17 Interrupt Force Clear n (IFC[n]) - Interrupt force clear for interrupt n
- 16 Reserved
- 15:1 Interrupt Force n (IF[n]) - Force interrupt nr n
- 0 Reserved

## 40.3.10 Extended Interrupt Acknowledge Register

Table 524. 0x800020C0 - PEXTACK - Extended Interrupt Acknowledge Register

31		6	5		0
RESERVED				EID[5:0]	
0				0	
r				r	

- 31:6 Reserved
- 5:0 Extended interrupt ID (EID) - ID (16-63) of the most recent acknowledged extended interrupt  
If this field is 0, and support for extended interrupts exist, the last assertion of interrupt *eirq* was not the result of an extended interrupt being asserted. If interrupt *eirq* is forced, or asserted, this field will be cleared unless one, or more, of the interrupts 63 - 16 are enabled and set in the pending register.

## 40.3.11 Interrupt Timestamp Counter Register

Table 525. 0x80002100 - TCNT0 - Interrupt Timestamp 0 Counter register

31		0
TCNT		
0		
r		

- 31:0 Timestamp Counter (TCNT) - Current value of timestamp counter. The counter increments whenever a TSISEL field in a Timestamp Control Register is non-zero. The counter will wrap to zero upon overflow and is read only.

# LEON3FT Microcontroller

Table 526. 0x80002110 - TCNT1 - Interrupt Timestamp 1 Counter register

31	0
TCNT	
0	
r	

31:0      Timestamp Counter (TCNT) - Current value of timestamp counter. The counter increments whenever a TSISEL field in a Timestamp Control Register is non-zero. The counter will wrap to zero upon overflow and is read only.

Table 527. 0x80002120 - TCNT2 - Interrupt Timestamp 2 Counter register

31	0
TCNT	
0	
r	

31:0      Timestamp Counter (TCNT) - Current value of timestamp counter. The counter increments whenever a TSISEL field in a Timestamp Control Register is non-zero. The counter will wrap to zero upon overflow and is read only.

Table 528. 0x80002130 - TCNT3 - Interrupt Timestamp 3 Counter register

31	0
TCNT	
0	
r	

31:0      Timestamp Counter (TCNT) - Current value of timestamp counter. The counter increments whenever a TSISEL field in a Timestamp Control Register is non-zero. The counter will wrap to zero upon overflow and is read only.

# LEON3FT Microcontroller

## 40.3.12 Timestamp Control Register

Table 529. 0x80002104 - ITSTMPC0 - Timestamp 0 Control Register

31		27	26	25	24	6			5	4	0
TSTAMP		S1	S2	RESERVED			KS			TSISEL	
0x4		0	0	0			0			0	
r		wc	wc	r			rw			rw	

- 31:27      Number of timestamp register sets (TSTAMP) - The number of available timestamp register sets.
- 26        Assertion Stamped (S1) - Set to '1' when the assertion of the selected line has received a timestamp. This bit is cleared by writing '1' to its position. Writes of '0' have no effect.
- 25        Acknowledge Stamped (S2) - Set to '1' when the processor acknowledge of the selected interrupt has received a timestamp. This bit can be cleared by writing '1' to this position, writes of '0' have no effect. This bit can also be cleared automatically by the core, see description of the KS field below.
- 24:6      RESERVED
- 5         Keep Stamp (KS) - If this bit is set to '1' the core will keep the first stamp value for the first interrupt until the S1 and S2 fields are cleared by software. If this bit is set to '0' the core will time stamp the most recent interrupt. This also has the effect that the core will automatically clear the S2 field whenever the selected interrupt line is asserted and thereby also stamp the next acknowledge of the interrupt.
- 4:0       Timestamp Interrupt Select (TSISEL) - This field selects the interrupt number (1 - 31) to timestamp.

Table 530. 0x80002114 - ITSTMPC1 - Timestamp 1 Control Register

31		27	26	25	24	6			5	4	0
TSTAMP		S1	S2	RESERVED			KS			TSISEL	
0x4		0	0	0			0			0	
r		wc	wc	r			rw			rw	

- 31:27      Number of timestamp register sets (TSTAMP) - The number of available timestamp register sets.
- 26        Assertion Stamped (S1) - Set to '1' when the assertion of the selected line has received a timestamp. This bit is cleared by writing '1' to its position. Writes of '0' have no effect.
- 25        Acknowledge Stamped (S2) - Set to '1' when the processor acknowledge of the selected interrupt has received a timestamp. This bit can be cleared by writing '1' to this position, writes of '0' have no effect. This bit can also be cleared automatically by the core, see description of the KS field below.
- 24:6      RESERVED
- 5         Keep Stamp (KS) - If this bit is set to '1' the core will keep the first stamp value for the first interrupt until the S1 and S2 fields are cleared by software. If this bit is set to '0' the core will time stamp the most recent interrupt. This also has the effect that the core will automatically clear the S2 field whenever the selected interrupt line is asserted and thereby also stamp the next acknowledge of the interrupt.
- 4:0       Timestamp Interrupt Select (TSISEL) - This field selects the interrupt number (1 - 31) to timestamp.

# LEON3FT Microcontroller

Table 531. 0x80002124 - ITSTMPC2 - Timestamp 2 Control Register

31	27	26	25	24	6	5	4	0
TSTAMP	S1	S2	RESERVED			KS	TSISEL	
0x4	0	0	0			0	0	
r	wc	wc	r			rw	rw	

- 31:27      Number of timestamp register sets (TSTAMP) - The number of available timestamp register sets.
- 26        Assertion Stamped (S1) - Set to '1' when the assertion of the selected line has received a timestamp. This bit is cleared by writing '1' to its position. Writes of '0' have no effect.
- 25        Acknowledge Stamped (S2) - Set to '1' when the processor acknowledge of the selected interrupt has received a timestamp. This bit can be cleared by writing '1' to this position, writes of '0' have no effect. This bit can also be cleared automatically by the core, see description of the KS field below.
- 24:6      RESERVED
- 5         Keep Stamp (KS) - If this bit is set to '1' the core will keep the first stamp value for the first interrupt until the S1 and S2 fields are cleared by software. If this bit is set to '0' the core will time stamp the most recent interrupt. This also has the effect that the core will automatically clear the S2 field whenever the selected interrupt line is asserted and thereby also stamp the next acknowledge of the interrupt.
- 4:0        Timestamp Interrupt Select (TSISEL) - This field selects the interrupt number (1 - 31) to timestamp.

Table 532. 0x80002104 - ITSTMPC3 - Timestamp 3 Control Register

31	27	26	25	24	6	5	4	0
TSTAMP	S1	S2	RESERVED			KS	TSISEL	
0x4	0	0	0			0	0	
r	wc	wc	r			rw	rw	

- 31:27      Number of timestamp register sets (TSTAMP) - The number of available timestamp register sets.
- 26        Assertion Stamped (S1) - Set to '1' when the assertion of the selected line has received a timestamp. This bit is cleared by writing '1' to its position. Writes of '0' have no effect.
- 25        Acknowledge Stamped (S2) - Set to '1' when the processor acknowledge of the selected interrupt has received a timestamp. This bit can be cleared by writing '1' to this position, writes of '0' have no effect. This bit can also be cleared automatically by the core, see description of the KS field below.
- 24:6      RESERVED
- 5         Keep Stamp (KS) - If this bit is set to '1' the core will keep the first stamp value for the first interrupt until the S1 and S2 fields are cleared by software. If this bit is set to '0' the core will time stamp the most recent interrupt. This also has the effect that the core will automatically clear the S2 field whenever the selected interrupt line is asserted and thereby also stamp the next acknowledge of the interrupt.
- 4:0        Timestamp Interrupt Select (TSISEL) - This field selects the interrupt number (1 - 31) to timestamp.

# LEON3FT Microcontroller

## 40.3.13 Interrupt Assertion Timestamp Register

Table 533. 0x80002108 - ITSTMPAS0 - Interrupt Assertion Timestamp 0 register

31	0
TASSERTION	
0	
r	

31:0      Timestamp of Assertion (TASSERTION) - The current Timestamp Counter value is saved in this register when timestamping is enabled and the interrupt line selected by TSISEL is asserted.

Table 534. 0x80002118 - ITSTMPAS1 - Interrupt Assertion Timestamp 1 register

31	0
TASSERTION	
0	
r	

31:0      Timestamp of Assertion (TASSERTION) - The current Timestamp Counter value is saved in this register when timestamping is enabled and the interrupt line selected by TSISEL is asserted.

Table 535. 0x80002128 - ITSTMPAS2 - Interrupt Assertion Timestamp 2 register

31	0
TASSERTION	
0	
r	

31:0      Timestamp of Assertion (TASSERTION) - The current Timestamp Counter value is saved in this register when timestamping is enabled and the interrupt line selected by TSISEL is asserted.

Table 536. 0x80002138 - ITSTMPAS3 - Interrupt Assertion Timestamp 3 register

31	0
TASSERTION	
0	
r	

31:0      Timestamp of Assertion (TASSERTION) - The current Timestamp Counter value is saved in this register when timestamping is enabled and the interrupt line selected by TSISEL is asserted.



# LEON3FT Microcontroller

## 40.3.14 Interrupt Acknowledge Timestamp Register

Table 537. 0x8000210C - ITSTMPAS0 - Interrupt Acknowledge Timestamp 0 register

31	0
TACKNOWLEDGE	
0	
r	

31:0      Timestamp of Acknowledge (TACKNOWLEDGE) - The current Timestamp Counter value is saved in this register when timestamping is enabled, the Acknowledge Stamped (S2) field is '0', and the interrupt selected by TSISEL is acknowledged by a processor connected to the interrupt controller.

Table 538. 0x8000211C - ITSTMPAS1 - Interrupt Acknowledge Timestamp 1 register

31	0
TACKNOWLEDGE	
0	
r	

31:0      Timestamp of Acknowledge (TACKNOWLEDGE) - The current Timestamp Counter value is saved in this register when timestamping is enabled, the Acknowledge Stamped (S2) field is '0', and the interrupt selected by TSISEL is acknowledged by a processor connected to the interrupt controller.

Table 539. 0x8000212C - ITSTMPAS2 - Interrupt Acknowledge Timestamp 2 register

31	0
TACKNOWLEDGE	
0	
r	

31:0      Timestamp of Acknowledge (TACKNOWLEDGE) - The current Timestamp Counter value is saved in this register when timestamping is enabled, the Acknowledge Stamped (S2) field is '0', and the interrupt selected by TSISEL is acknowledged by a processor connected to the interrupt controller.

Table 540. 0x8000213C - ITSTMPAS3 - Interrupt Acknowledge Timestamp 3 register

31	0
TACKNOWLEDGE	
0	
r	

31:0      Timestamp of Acknowledge (TACKNOWLEDGE) - The current Timestamp Counter value is saved in this register when timestamping is enabled, the Acknowledge Stamped (S2) field is '0', and the interrupt selected by TSISEL is acknowledged by a processor connected to the interrupt controller.

# LEON3FT Microcontroller

## 40.3.15 Processor Boot Address Register

Table 541. 0x80002200 - PROCBOOTADR - Processor boot address register

31		3	2	1	0
BOOTADDR[31:3]				RES	AS
-				-	-
w				-	w

- 31:3            Entry point for booting up processor, 8-byte aligned
- 2:1            Reserved (write 0)
- 0              Start processor immediately after setting address

\* For usage of this register see chapter 40.2.7

## 40.3.16 Interrupt Map Register

Table 542. 0x80002300 + 0x4 \* n - IRQMAPn - Interrupt map register

31	24	23	16	15	8	7	0
IID[n*4+0]		IID[n*4+1]		IID[n*4+2]		IID[n*4+3]	
**		**		**		**	
rw		rw		rw		rw	

- 31 : 24            Interrupt bus map  $n$  (ID[n\*4+0]) - Map register for bus interrupt line [n\*4+0]
- 23 : 16            Interrupt bus map  $n$  (ID[n\*4+1]) - Map register for bus interrupt line [n\*4+1]
- 15 : 8             Interrupt bus map  $n$  (ID[n\*4+2]) - Map register for bus interrupt line [n\*4+2]
- 7 : 0              Interrupt bus map  $n$  (ID[n\*4+3]) - Map register for bus interrupt line [n\*4+3]

\* Number of interrupts in LEON3FT microcontroller is 64 hence  $n$  is 16

\*\* Default values for interrupt bus ID is found in table 543

# LEON3FT Microcontroller

Table 543. Remap default settings (TBC)

Address	Register	Bit field	Default	Interrupt Line	Core
0x80002300	IRQMAP0	ID0	-	0	n/a
		ID1	1	1	Extended
		ID2	2	2	GRPWRX
		ID3	3	3	GRPWTX
0x80002304	IRQMAP1	ID4	4	4	GR1553
		ID5	5	5	GRSPW2
		ID6	6	6	GRDMAC
		ID7	7	7	I2CS/2AHB/SPI2AHB
0x80002308	IRQMAP2	ID8	8	8	GRPWM
		ID9	9	9	GPTIMER0
		ID10	10	10	GPTIMER0
		ID11	11	11	GPTIMER0
0x8000230C	IRQMAP3	ID12	12	12	GPTIMER0
		ID13	13	13	GPTIMER0
		ID14	14	14	GPTIMER0
		ID15	15	15	GPTIMER0
0x80002310	IRQMAP4	ID16	16	16	GRADCDC
		ID17	17	17	GRGPIO
		ID18	18	18	GRGPIO
		ID19	19	19	GRGPIO
0x80002314	IRQMAP5	ID20	20	20	GRGPIO
		ID21	21	21	GRCAN0&1
		ID22	22	22	GRCAN0&1
		ID23	23	23	GRCAN0&1
0x80002318	IRQMAP6	ID24	24	24	APBUART0
		ID25	25	25	APBUART1
		ID26	26	26	DAC
		ID27	27	27	DAC
0x8000231C	IRQMAP7	ID28	28	28	ADC0
		ID29	29	29	ADC1
		ID30	30	30	ADC2
		ID31	31	31	ADC3

# LEON3FT Microcontroller

Address	Register	Bit field	Default	Interrupt Line	Core
0x80002320	IRQMAP8	ID32	28	32	ADC4
		ID33	29	33	ADC5
		ID34	30	34	ADC6
		ID35	31	35	ADC7
0x80002324	IRQMAP9	ID36	26	36	DAC
		ID37	27	37	DAC
		ID38	16	38	GRGPIO
		ID39	17	39	GRGPIO
0x80002328	IRQMAP10	ID40	18	40	GRGPIO
		ID41	19	41	GRGPIO
		ID42	3	42	APBUART2
		ID43	4	43	GRSPWTDTP
0x8000232C	IRQMAP11	ID44	5	44	APBUART4
		ID45	6	45	APBUART5
		ID46	7	46	APBUART6
		ID47	8	47	I2CSLV1 / I2C2AHB
0x80002330	IRQMAP12	ID48	11	48	SPICTRL
		ID49	12	49	SPICTRL
		ID50	13	50	I2CM
		ID51	14	51	I2CM
0x80002334	IRQMAP13	ID52	2	52	SPIMCTRL
		ID53	20	53	GPTIMER1
		ID54	21	54	GPTIMER1
		ID55	22	55	GPTIMER1
0x80002338	IRQMAP14	ID56	23	56	GPTIMER1
		ID57	24	57	GPTIMER1
		ID58	25	58	GPTIMER1
		ID59	26	59	GPTIMER1
0x8000233C	IRQMAP15	ID60	16	60	GRGPIOSEQ0
		ID61	17	61	GRGPIOSEQ1
		ID62	18	62	PLL
		ID63	19	63	AHBSTAT

# LEON3FT Microcontroller

## 41 LEON3 Statistics Unit

### 41.1 Overview

The LEON3 Statistics Unit (L3STAT) is used count events in the LEON3 processor and the AHB bus, in order to create performance statistics for various software applications.

The L3STAT core in the LEON3FT microcontroller consists of 4 32-bit counters, which increment on a certain event. The counters roll over to zero when reaching their maximum value, but can also be automatically cleared on reading to facilitate statistics building over longer periods. Each counter has a control register where the event type is selected. The table 544 below shows the event types that can be monitored.

Table 544. Event types and IDs for Main and DMA AMBA bus

ID	Event description
Processor events:	
0x10	Data write buffer hold
0x11	Total instruction count
0x12	Integer instructions
0x13	Floating-point unit instruction count
0x14	Branch prediction miss
0x15	Execution time, excluding debug mode
0x17	AHB utilization (per AHB master)
0x18	AHB utilization (total, master/CPU selection is ignored)
0x22	Integer branches
0x28	CALL instructions
0x30	Regular type 2 instructions
0x38	LOAD and STORE instructions
0x39	LOAD instructions
0x3A	STORE instructions
AHB events	
0x40	AHB IDLE cycles.
0x41	AHB BUSY cycles.
0x42	AHB NON-SEQUENTIAL transfers. Filtered on CPU/AHBM if SU(1) = '1'
0x43	AHB SEQUENTIAL transfers. Filtered on CPU/AHBM if SU(1) = '1'
0x44	AHB read accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x45	AHB write accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x46	AHB byte accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x47	AHB half-word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x48	AHB word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x49	AHB double word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x4A	AHB quad word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x4B	AHB eight word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x4C	AHB waitstates. Filtered on CPU/AHBM if SU(1) = '1'
0x4D	AHB RETRY responses. Filtered on CPU/AHBM if SU(1) = '1'
0x4E	AHB SPLIT responses. Filtered on CPU/AHBM if SU(1) = '1'
0x4F	AHB SPLIT delay. Filtered on CPU/AHBM if SU(1) = '1'
0x50	AHB bus locked. Filtered on CPU/AHBM if SU(1) = '1'
0x51-0x5F	Reserved

# LEON3FT Microcontroller

Table 544. Event types and IDs for Main and DMA AMBA bus

ID	Event description
Implementation specific events:	
0x60	External event correctable error in Data on-chip RAM.
0x61	External event correctable error in Instruction on-chip RAM.
0x62	External event uncorrectable error in Data on-chip RAM.
0x63	External event uncorrectable error in Instruction on-chip RAM.
0x64	External event correctable error in Off-chip RAM/ROM.
0x65	External event correctable error in NVRAM RAM/ROM.
0x66	External event correctable error in SPI PROM0.
0x67	External event correctable error in SPI PROM1.
0x68	Not used
0x69	Not used
0x6A	Not used
0x6B	Not used
0x6C	Not used
0x6D	Not used
0x6E	Not used
0x6F	Not used
AHB events	
0x70	AHB IDLE cycles.
0x71	AHB BUSY cycles. Filtered on CPU/AHBM if SU(1) = '1'
0x72	AHB NON-SEQUENTIAL transfers. Filtered on CPU/AHBM if SU(1) = '1'
0x73	AHB SEQUENTIAL transfers. Filtered on CPU/AHBM if SU(1) = '1'
0x74	AHB read accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x75	AHB write accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x76	AHB byte accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x77	AHB half-word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x78	AHB word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x79	AHB double word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x7A	AHB quad word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x7B	AHB eight word accesses. Filtered on CPU/AHBM if SU(1) = '1'
0x7C	AHB waitstates. Filtered on CPU/AHBM if SU(1) = '1'
0x7D	AHB RETRY responses. Filtered on CPU/AHBM if SU(1) = '1'
0x7E	AHB SPLIT responses. Filtered on CPU/AHBM if SU(1) = '1'
0x7F	AHB SPLIT delay. Filtered on CPU/AHBM if SU(1) = '1'
Events generated from REQ/GNT signals	
0x80 - 0x8F	Active when master selected by CPU/AHBM field has request asserted while grant is asserted for the master corresponding to the least significant nibble of the event ID. 0x80 is master 0 grant, 0x81 is master 1 grant, ..., and so on. For the LEON3FT Microcontroller ID 0x80 to 0x83 is used for the main system bus and 0x80 to 0x87 is used for the DMA bus
0x80*	Request by LEON3FT
0x81*	Request by DMA => Main bridge
0x82*	Request by Scrubber
0x80**	Request by Debug UART
0x81**	Request by 1553 core
0x82**	Request by SpaceWire core

# LEON3FT Microcontroller

Table 544. Event types and IDs for Main and DMA AMBA bus

ID	Event description
0x83**	Request by CAN core 0
0x84**	Request by CAN core 1
0x85**	Request by AHBUART core
0x86**	Request by Main => DMA bridge
0x87**	Request by PWRX core
0x88**	Request by PWTX core
0x89**	Request by DMA core 0
0x8A**	Request by DMA core 1
0x90 - 0x9F	Active when master selected by CPU/AHBM field has request asserted while grant is deasserted for the master corresponding to the least significant nibble of the event ID. 0x90 is master 0 grant, 0x91 is master 1 grant, .., and so on.

\* Only valid for L3STAT for Main system bus

\*\* Only valid for L3STAT for DMA bus

Note that IDs 0x39 (LOAD instructions) and 0x3A (STORE instructions) will both count all LDST and SWAP instructions. The sum of events counted for 0x39 and 0x3A may therefore be larger than the number of events counted with ID 0x38 (LOAD and STORE instructions).

## 41.2 Using the LEON3 statistics unit

The debug monitor GRMON3 has build-in support for using LEON3 statistical unit. For more information see chapter for using the LEON3 statistical unit in the GRMON3 User's Manual [GRMON3].

## 41.3 Registers

The L3STAT core is programmed through registers mapped into APB address space.

Table 545. L3STAT counter control register\*

APB address offset	Register
0x0	Counter 0 value register
0x4	Counter 1 value register
0x8	Counter 2 value register
0xC	Counter 3 value register
0x100	Counter 0 control register
0x104	Counter 1 control register
0x108	Counter 2 control register
0x10C	Counter 3 control register
0x200	Counter 0 max/latch register
0x204	Counter 1 max/latch register
0x208	Counter 2 max/latch register
0x20C	Counter 3 max/latch register
0x300	Timestamp register

# LEON3FT Microcontroller

## 41.3.1 Counter Value Register

Table 546.0x00+n.4 - CVALn - Counter value register

31	0
CVAL	
NR	
rw	

- 31: 0 Counter value (CVAL) - This register holds the current value of the counter. If the Counter control register field CD is '1', then the value displayed by this register will be the maximum counter value reached with the settings in the counter's control register. Writing to this register will write both to the counter and the hold register for the maximum counter value.

## 41.3.2 Counter Control Register

Table 547.0x100+n.4 - CTRLn - Counter control register

31	28	27	23	22	21	20	19	18	17	16	15	14	13	12	11	4	3	0
NCPU		NCNT		MC	IA	DS	EE	AE	EL	CD	SU	CL	EN	EVENT ID			CPU/AHBM	
0		3		1	1	1	1	1	NR	NR	NR	NR	0	NR			NR	
r		r		r	r	r	r	r	rw	rw	rw	rw	rw	rw			rw	

- 31: 28 Number of CPU (NCPU) - Number of supported processors - 1
- 27: 23 Number of counters (NCNT) - Number of implemented counters - 1
- 22 Maximum count (MC) - This field is '1' indicating that the counter has support for keeping the maximum count value
- 21 Internal AHB count (IA) - This field is '1' indicating that the core supports events 0x17 and 0x18
- 20 DSU support (DS) - This field is '1' indicating that the core supports events 0x40-0x5F
- 19 External events (EE) - This field is '1' indicating that the core supports external events (events 0x60 - 0x6F)
- 18 AHBTRACE Events (AE) - This field is '1' indicating that the core supports events 0x70 - 0x7F.
- 17 Event Level (EL) - The value of this field determines the level where the counter keeps running when the CD field below has been set to '1'. If this field is '0' the counter will count the time between event assertions. If this field is '1' the counter will count the cycles where the event is asserted.
- 16 Count maximum duration (CD) - If this bit is set to '1' the core will save the maximum time the selected event has been at the level specified by the EL field. This also means that the counter will be reset when the event is activated or deactivated depending on the value of the EL field.  
When this bit is set to '1', the value shown in the counter value register will be the maximum current value which may be different from the current value of the counter.
- 15: 14 Supervisor/User mode filter (SU) - "01" - Only count supervisor mode events, "10" - Only count user mode events, others values - Count events regardless of user or supervisor mode. This setting only applies to events 0x0 - 0x3A.  
When SU = "1x" only events generated by the CPU/AHB master specified in the CPU/AHBM field will be counted. This applies to events 0x40 - 0x7F.
- 13 Clear counter on read (CL) - If this bit is set the counter will be cleared when the counter's value is read. The register holding the maximum value will also be cleared.  
If an event occurs in the same cycle as the counter is cleared by a read then the event will not be counted. The counter latch register can be used to guarantee that no events are lost
- 12 Enable counter (EN) - Enable counter
- 11: 4 Event ID to be counted
- 3: 0 CPU or AHB master to monitor.(CPU/AHBM) - The value of this field does not matter when selecting one of the events coming from the Debug Support Unit or one of the external events.



# LEON3FT Microcontroller

## 41.3.3 Counter max/latch Register

Table 548.0x200+4n - CSVALn - Counter max/latch register

31	0
CSVAL	
NR	
rw*	

31: 0 Counter max/latch value (CSVAL) - This register holds the current value of the counter max/latch register.

If the counter control register field CD is '1', then the value displayed by this register will be the maximum counter value reached with the settings in the counter's control register.

If the counter control register field CD is '0', then the value displayed by this register is the latched (saved) counter value. The counter value is saved whenever a write access is made to the core in address range 0x100 - 0x1FC (all counters are saved simultaneously). If the counter control register CL field is set, then the current counter value will be cleared when the counter value is saved into this register.

## 41.3.4 Timestamp Register

Table 549.0x300 - TSTAMP - Timestamp register

31	0
TSTAMP	
NR	
rw*	

31: 0 Timestamp (TSTAMP) - Timestamp taken at latch of counters

# LEON3FT Microcontroller

## 42 Memory Scrubber and Status Register

The GR716 microcontroller have 1 AHB Memory Scrubber and Status Register unit (MEMSCRUB).

The MEMSCRUB unit monitors the system main bus or scrubber bus for accesses triggering an error response, and for correctable errors signaled from fault tolerant slaves on the bus. The MEMSCRUB unit can be programmed to scrub memories. The AHB Memory Scrubber and Status Register unit (MEMSCRUB) have a unique AMBA address described in chapter 2.10 for configuration and status.

The AHB Memory Scrubber and Status Register unit (MEMSCRUB) unit is located on AHB bus in the address range from 0xFFF00000 to 0xFFF00FFF.

See units connections in the next drawing. The drawing picture memory locations and functions used for configuration and control.

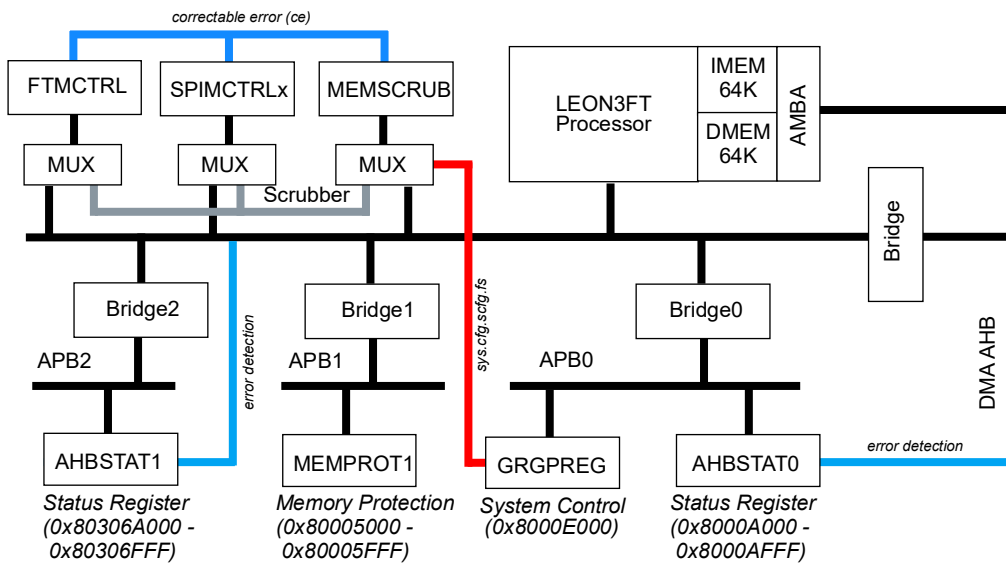


Figure 79. GR716 Scrubber and Status bus connection

# LEON3FT Microcontroller

## 42.1 Overview

The memory scrubber monitors an AMBA AHB bus for accesses triggering an error response, and for correctable errors signaled from fault tolerant slaves on the bus. The core can be programmed to scrub a memory area by reading through the memory and writing back the contents using a locked read-write cycle whenever a correctable error is detected. It can also be programmed to initialize a memory area to known values.

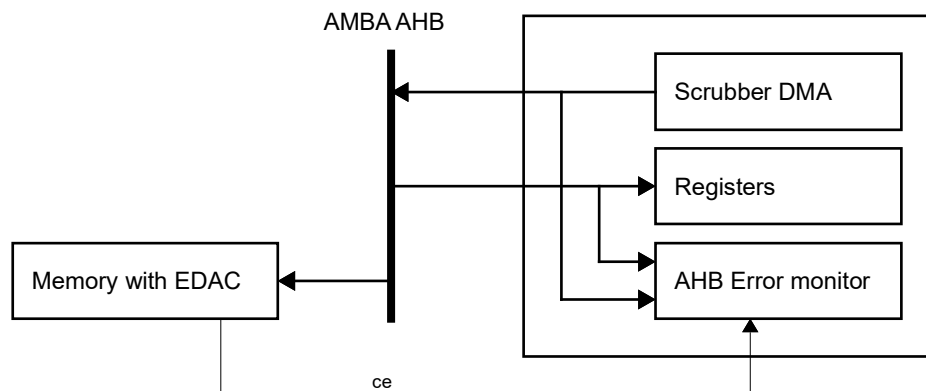


Figure 80. Memory scrubber block diagram

## 42.2 Operation

### 42.2.1 Errors

All AMBA AHB bus transactions are monitored and current HADDR, HWRITE, HMASTER and HSIZE values are stored internally. When an error response (HRESP = "01") is detected, an internal counter is increased. When the counter exceeds a user-selected threshold, the status and address register contents are frozen and the New Error (NE) bit is set to one. At the same time an interrupt is generated, as described hereunder.

The default threshold is zero and enabled on reset so the first error on the bus will generate an interrupt.

Note that many of the fault tolerant units containing EDAC signal an un-correctable error as an AMBA error response, so that it can be detected by the processor as described above.

### 42.2.2 Correctable errors

Not only error responses on the AHB bus can be detected. Many of the fault tolerant units containing EDAC have a correctable error signal which is asserted each time a correctable error is detected. When such an error is detected, the effect will be the same as for an AHB error response. The only difference is that the Correctable Error (CE) bit in the status register is set to one when a correctable error is detected. Correctable and uncorrectable errors use separate counters and threshold values.

When the CE bit is set, the interrupt routine can acquire the address containing the correctable error from the failing address register and correct it. When it is finished it resets the CE bit and the monitoring becomes active again. Interrupt handling is described in detail hereunder.

### 42.2.3 Scrubbing

The memory scrubber can be commanded to scrub a certain memory area, by writing a start and end address to the scrubbers start/end registers, followed by writing "00" to the scrub mode field and '1' to the scrub enable bit in the scrubber control register.

# LEON3FT Microcontroller

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After starting, the core will proceed to read the memory region in bursts. The burst size is fixed and typically tuned to match the cache-line size or native block size of the slave. When a correctable error is detected, the scrubber performs a locked read-write cycle to correct the error, and then resumes the scrub operation.

If the correctable error detected is in the middle of a burst, the following read in the burst is completed before the read-write cycle begins. The core can handle the special case where that access also had a correctable error within the same locked scrub cycle.

If an uncorrectable error is detected, that location is left untouched.

Note that the status register functionality is running in parallel with the scrubber, so correctable and uncorrectable errors will be logged as usual. To prevent double logging, the core masks out the (expected) correctable error arising during the locked correction cycle.

To allow normal access to the bus, the core sleeps for a number of cycles between each burst. The number of cycles can be adjusted in the config register.

If the ID bit is set in the config register, the core will interrupt when the complete scrub is done.

## 42.2.4 Scrubber error counters

The core keeps track of the number of correctable errors detected during the current scrub run and the number of errors detected during processing of the current “count block”. The size of the count block is a fixed power of two equal or larger than the burst length .

The core can be set up to interrupt when the counters exceed given thresholds. When this happens, the NE bit, plus one of the SEC/SBC bits, is set in the status register.

## 42.2.5 External start and clear

If the ES bit is set in the config register, the scrub enable bit is set automatically when the start input signal goes high. This can be used to set up periodic scrubbing.

The external input signal clerr can be used to clear the global error counters. If this is connected to a timer, it is possible to count errors that have occurred within a specific unit of time. This signal can be disabled through the EC bit in the config register.

## 42.2.6 Memory regeneration

The regeneration mode performs the same basic function as the scrub mode, but is optimised for the case where many (or all) locations have correctable errors.

In this mode, the whole memory area selected is scrubbed using locked read/write bursts.

If an uncorrectable error is encountered during the read burst, that burst block is processed once again using the regular scrub routine, and the regeneration mode resumes on the following block. This avoids overwriting uncorrectable error locations.

## 42.2.7 Initialization

The scrubber can be used to write a pre-defined pattern to a block of memory. This is often necessary on EDAC memory before it can be used.

Before running the initialization, the pattern to be written to memory should be written into the scrubber initialization data register. The pattern has the same size as the burst length, so the corresponding number of writes to the initialization data register must be made.

## 42.2.8 Interrupts

After an interrupt is generated, either the NE bit or the DONE bit in the status register is set, to indicate which type of event caused the interrupt.

# LEON3FT Microcontroller

The normal procedure is that an interrupt routine handles the error with the aid of the information in the status registers. When it is finished it resets the NE bit in the AHB status register or the DONE bit in the scrubber status register, and the monitoring becomes active again. Error interrupts can be generated for both AMBA error responses and correctable errors as described above.

## 42.2.9 Mode switching

Switching between scrubbing and regeneration modes can be done on the fly during a scrub by modifying the MODE field in the scrubber configuration register. The mode change will take effect on the following scrub burst.

If the address range needs to be changed, then the core should be stopped before updating the registers. This is done by clearing the SCEN bit, and waiting for the ACTIVE bit in the status register to go low. An exception is when making the range larger (i.e. increasing the end address or decreasing the start address), as this can be done on the fly.

## 42.2.10 Dual range support

The scrubber can work over two non-overlapping memory ranges. This feature is enabled by writing the start/end addresses of the second range into the scrubber's second range start/end registers and setting the SERA bit in the configuration register. The two address ranges should not overlap.

## 42.3 Registers

The core is programmed through registers mapped into an I/O region in the AHB address space. Only 32-bit accesses are supported.

Table 550. Memory scrubber registers

AHB address offset	Registers
<i>AHB Memory Scrubber and Status Register unit (MEMSCRUB)</i>	
0xFFF00000	AHB Status register
0xFFF00004	AHB Failing address register
0xFFF00008	AHB Error configuration register
0xFFF0000C	Reserved
0xFFF00010	Scrubber status register
0xFFF00014	Scrubber configuration register
0xFFF00018	Scrubber range low address register
0xFFF0001C	Scrubber range high address register
0xFFF00020	Scrubber position register
0xFFF00024	Scrubber error threshold register
0xFFF00028	Scrubber initialization data register
0xFFF0002C	Scrubber second range start address register
0xFFF00030	Scrubber second range end address register

# LEON3FT Microcontroller

## 42.3.1 AHB Status Register

Table 551. 0x00 - AHBS - AHB Status register

31	22	21	14	13	12	11	10	9	8	7	6	3	2	0
CECNT		UECNT		DONE	RES	SEC	SBC	CE	NE	HWRITE	HMASTER	HSIZE		
0		0		0	0	0	0	0	0	NR	NR	NR		
rw		rw		r	r	rw	rw	rw	rw	r	r	r		

- 31: 22      CECNT: Global correctable error count
- 21: 14      UECNT: Global uncorrectable error count
- 13          DONE: Task completed. (read-only)  
This is a read-only copy of the DONE bit in the status register.
- 12          RESERVED
- 11          SEC: Scrubber error counter threshold exceeded. Asserted together with NE.
- 10          SBC: Scrubber block error counter threshold exceeded. Asserted together with NE.
- 9           CE: Correctable Error. Set if the detected error was caused by a correctable error and zero otherwise.
- 8           NE: New Error. Deasserted at start-up and after reset. Asserted when an error is detected. Reset by writing a zero to it.
- 7           The HWRITE signal of the AHB transaction that caused the error.
- 6: 3        The HMASTER signal of the AHB transaction that caused the error.
- 2: 0        The HSIZE signal of the AHB transaction that caused the error

## 42.3.2 AHB Failing Address Register

Table 552. 0x04 - AHB FAR - AHB Failing address register

31	AHB FAILING ADDRESS													0
NR														
r														

- 31: 0        The HADDR signal of the AHB transaction that caused the error.

## 42.3.3 AHB Error Configuration Register

Table 553. 0x08 - AHB ERC - AHB Error configuration register

31	22	21	14	13	2	1	0	
CORRECTABLE ERROR COUNT THRESHOLD			UNCORR. ERROR COUNT THRESH.		RESERVED		CECTE	UECTE
0			0		0		0	0
rw			rw		r		rw	rw

- 31: 22      Interrupt threshold value for global correctable error count
- 21: 14      Interrupt threshold value for global uncorrectable error count
- 13: 2       RESERVED
- 1           CECTE: Correctable error count threshold enable
- 0           UECTE: Uncorrectable error count threshold enable

# LEON3FT Microcontroller

## 42.3.4 Scrubber Status Register

Table 554. 0x10 - STAT - Scrubber status register

31	22	21	14	13	12	5	4	1	0
SCRUB RUN ERROR COUNT		BLOCK ERROR COUNT		DONE	RESERVED	BURSTLEN	ACTIVE		
0		0		0	0	*	0		
r		r		wc	r	r	r		

- 31: 22      Number of correctable errors in current scrub run (read-only)
- 21: 14      Number of correctable errors in current block (read-only)
- 13          DONE: Task completed.  
Needs to be cleared (by writing zero) before a new task completed interrupt can occur.
- 12: 5        RESERVED
- 4: 1         Burst length in 2-log of AHB bus cycles; “0000”=1, “0001”=2, “0010”=4, “0011”=8, ...
- 0            Current state: 0=Idle, 1=Running (read-only)

## 42.3.5 Scrubber Configuration Register

Table 555. 0x14 - CONFIG - Scrubber configuration register

31	16	15	8	7	6	5	4	3	2	1	0
RESERVED		DELAY		IRQD	EC	SERA	LOOP	MODE	ES	SCEN	
0		0		0	0	0	0	0	0	0	
r		rw		rw	r	rw	rw	rw	rw	rw	

- 31: 16      RESERVED
- 15: 8        Delay time between processed blocks, in cycles
- 7            Interrupt when scrubber has finished
- 6            External clear counter enable
- 5            Second memory range enable
- 4            Loop mode, restart scrubber when run finishes
- 3: 2        Mode (00=Scrub, 01=Regenerate, 10=Initialize, 11=Undefined)
- 1            External start enable
- 0            Enable

## 42.3.6 Scrubber Range Low Address Register

Table 556. 0x18 - RANGEL - Scrubber range low address register

31	0
SCRUBBER RANGE LOW ADDRESS	
0	
rw	

- 31: 0        The lowest address in the range to be scrubbed  
The address bits below the burst size alignment are constant ‘0’

# LEON3FT Microcontroller

## 42.3.7 Scrubber Range High Address Register

Table 557. 0x1C - RANGEH - Scrubber range high address register

31	0
SCRUBBER RANGE HIGH ADDRESS	
0	
rw	

31: 0      The highest address in the range to be scrubbed  
 The address bits below the burst size alignment are constant '1'

## 42.3.8 Scrubber Position Register

Table 558. 0x20 - POS - Scrubber position register

31	0
SCRUBBER POSITION	
0	
rw	

31: 0      The current position of the scrubber while active, otherwise zero.  
 The address bits below the burst size alignment are constant '0'



# LEON3FT Microcontroller

## 42.3.9 Scrubber Error Threshold Register

Table 559. 0x24 - ERROR - Scrubber error threshold register

31	22 21	14 13	2 1	0
RECT	BECT	RESERVED	RECTE	BECTE
0	0	0	0	0
rw	rw	r	rw	rw

- 31: 22      Interrupt threshold value for current scrub run correctable error count
- 21: 14      Interrupt threshold value for current scrub block correctable error count
- 13: 2        RESERVED
- 1            RECTE: Scrub run correctable error count threshold enable
- 0            BECTE: Scrub block uncorrectable error count threshold enable

## 42.3.10 Scrubber Initialization Data Register

Table 560. 0x28 - INIT - Scrubber initialization data register (write-only)

31	SCRUBBER INITIALIZATION DATA	0
	-	
	w	

- 31: 0        Part of data pattern to be written in initialization mode. A write operation assigns the first part of the buffer and moves the rest of the words in the buffer one step.

## 42.3.11 Scrubber Second Range Low Address Register

Table 561. 0x2C - RANGEL2 - Scrubber second range low address register

31	SCRUBBER RANGE LOW ADDRESS	0
	0	
	rw*	

- 31: 0        The lowest address in the second range to be scrubbed  
The address bits below the burst size alignment are constant '0'

## 42.3.12 Scrubber Second Range High Address Register

Table 562. 0x30 - RANGEH2 - Scrubber second range high address register

31	SCRUBBER RANGE HIGH ADDRESS	0
	0	
	rw*	

- 31: 0        The highest address in the second range to be scrubbed  
The address bits below the burst size alignment are constant '1'

# LEON3FT Microcontroller

## 43 SPI to AHB bridge

The GR716 microcontroller comprises a SPI to AHB bridge (SPI2AHB). The SPI to AHB bridge controls its own external pins and has a unique AMBA address described in chapter 2.10. The SPI to AHB bridge is connected to external pins via the IOMUX.

The control and status registers are located on APB bus in the address range from 0x80104000 to 0x80104FFF. See SPI to AHB bridge connections in the next drawing. The figure shows memory locations and functions used for SPI2AHB configuration and control.

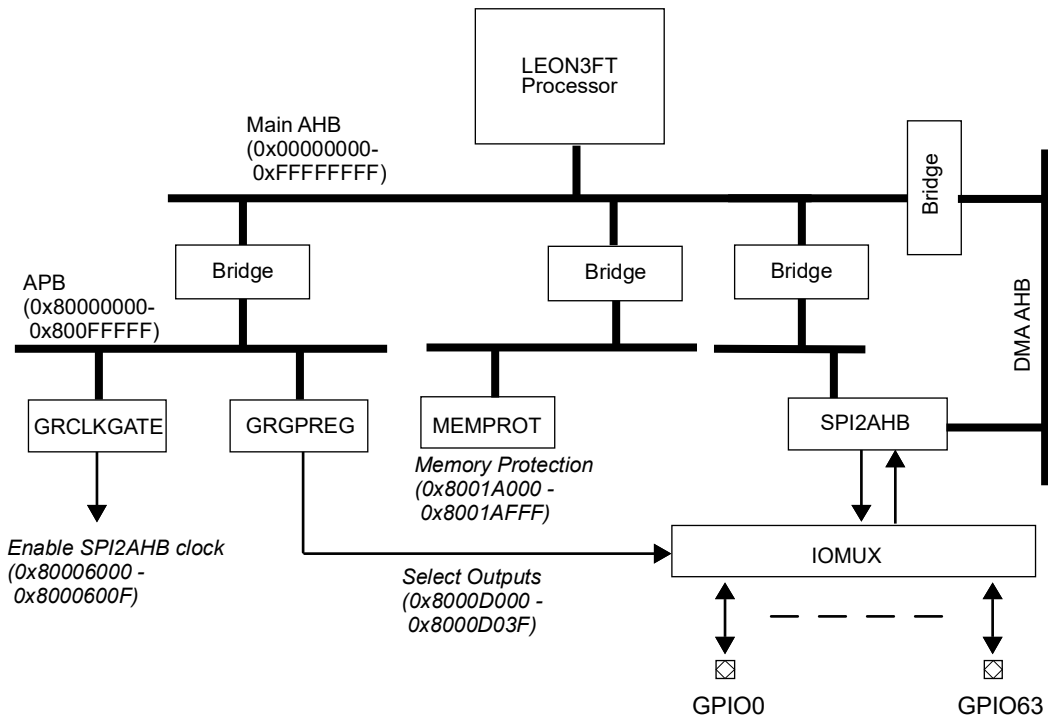


Figure 81. GR716 SPI2AHB bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the SPI to AHB bridge. The unit **GRCLKGATE** can also be used to perform reset of the SPI to AHB bridge. Software must enable clock and release reset described in section 27 before configuration and transmission can start.

External IO selection and configuration is made in the system IO configuration registers (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

The system can be configured to protect and restrict access to the SPI to AHB bridge in the **MEMPROT** unit. See section 47 for more information.

### 43.1 Overview

The SPI to AHB bridge is an SPI slave that provides a link between a SPI bus (that consists of two data signals, one clock signal and one select signal) and AMBA AHB. On the SPI bus the slave acts as an SPI memory device where accesses to the slave are translated to AMBA accesses. The core can translate SPI accesses to AMBA byte, half-word or word accesses. The access size to use is configurable via the SPI bus.

The core synchronizes the incoming clock and can operate in systems where other SPI devices are driven by asynchronous clocks.

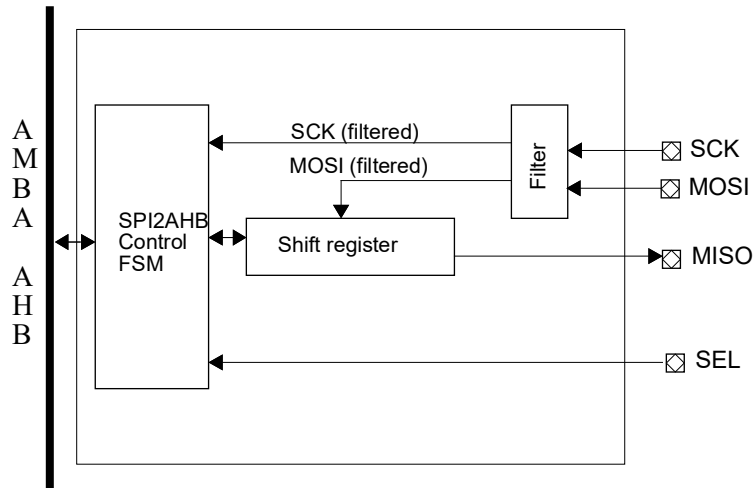


Figure 82. SPI to AHB bridge block diagram

## 43.2 Transmission protocol

The SPI bus is a full-duplex synchronous serial bus. Transmission starts when a master selects a slave through the slave’s Slave Select (SEL) signal and the clock line SCK transitions from its idle state. Data is transferred from the master through the Master-Output-Slave-Input (MOSI) signal and from the slave through the Master-Input-Slave-Output (MISO) signal. In some systems with only one master and one slave, the Slave Select input of the slave may be always active and the master does not need to have a slave select output. This does not apply to this SPI to AHB bridge, the slave select signal must be used to mark the start and end of an operation.

During a transmission on the SPI bus data is either changed or read at a transition of SCK. If data has been read at edge  $n$ , data is changed at edge  $n+1$ . If data is read at the first transition of SCK the bus is said to have clock phase 0, and if data is changed at the first transition of SCK the bus has clock phase 1. The idle state of SCK may be either high or low. If the idle state of SCK is low, the bus has clock polarity 0 and if the idle state is high the clock polarity is 1. The combined values of clock polarity (CPOL) and clock phase (CPHA) determine the mode of the SPI bus. Figure 83 shows one byte (0x55) being transferred MSb first over the SPI bus under the four different modes. Note that the idle state of the MOSI line is ‘1’ and that CPHA = 0 means that the devices must have data ready before the first transition of SCK. The figure does not include the MISO signal, the behavior of this line is the same as for the MOSI signal. However, due to synchronization the MISO signal will be delayed for a period of time that depends on the system clock frequency.

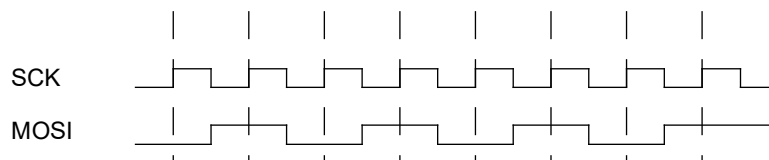


Figure 83. SPI transfer of byte 0x55 in all modes

The SPI to AHB bridge makes use of a protocol commonly used by SPI Flash memory devices. A master first selects the slave via the slave select signal and then issues a one-byte instruction. The instruction is then followed by additional bytes that contain address or data values. All instructions, addresses and data are transmitted with the most significant bit first. All AMBA accesses are done in big endian format. The first byte sent to or from the slave is the most significant byte.

# LEON3FT Microcontroller

## 43.3 System clock requirements and sampling

The core samples the incoming SPI SCK clock and does not introduce any additional clock domains into the system. Both the SCK and MOSI lines first pass through two stage synchronizers and are then filtered with a low pass filter.

The synchronizers and filters constrain the minimum system frequency. The core requires the SCK signal to be stable for at least two system clock cycles before the core accepts the SCK value as the new clock value. The core’s reaction to transitions will be additionally delayed since both lines are taken through two-stage synchronizers before they are filtered. In order for the slave to be able to output data on the SCK ‘change’ transition and for this data to reach the master before the next edge the SCK frequency should not be higher than one tenth of the system frequency of core.

The slave select input should be asserted at least two system clock cycles before the SCK line starts transitioning.

## 43.4 SPI instructions

### 43.4.1 Overview

The core is controlled from the SPI bus by sending SPI instructions. Some commands require additional bytes in the form of address or data. The core makes use of the same instructions as commonly available SPI Flash devices. Table 563 summarizes the available instructions.

Table 563. SPI instructions

Instruction	Description	Instruction code	Additional bytes
RDSR	Read status/control register	0x05	Core responds with register value
WRSR	Write status/control register	0x01	New register value
READ	AHB read access	0x03	Four address bytes, after which core responds with data.
READD	AHB read access with dummy byte	0x0B	Four address bytes and one dummy byte, after which core responds with data
WRITE	AHB write access	0x02	Four address bytes followed by data to be written

All instructions, addresses and data are transmitted with the most significant bit first. All AMBA accesses are done in big endian format. The first byte sent to or from the slave is the most significant byte.

### 43.4.2 SPI status/control register accesses (RDSR/WRSR)

The RDSR and WRSR instructions access the core’s SPI status/control register. The register is accessed by issuing the wanted instruction followed by the data byte to be written (WRSR) or any value on the byte in order to shift out the current value of the status/control register (RDSR). The fields available in the SPI status/control register are shown in table 564.

Table 564. SPI2AHB SPI status/control register

7	6	5	4	3	2	1	0
Reserved	RAHEAD	PROT	MEXC	DMAACT	MALF	HSIZE	

- 7 Reserved, always zero (read only)
- 6 Read ahead (RAHEAD) - When this bit is set the core will make a new access to fetch data as soon as the last current data bit has been moved. Otherwise the core will not attempt the new access until the ‘change’ transition on SCK. Setting this bit to ‘1’ allows higher SCK frequencies to be used but will also result in a data fetch as soon as the current data has been read out. This means that RAHEAD may not be suitable when accessing FIFO interfaces. (read/write)

# LEON3FT Microcontroller

Table 564. SPI2AHB SPI status/control register

- 5 Memory protection triggered (PROT) - '1' if last AHB access was outside the allowed memory area. Updated after each AMBA access (read only). Note that since this bit is updated after each access the RAHEAD = '1' setting may hide errors.
- 4 Memory exception (MEXC) - '1' if core receives AMBA ERROR response. Updated after each AMBA access (read only). Note that since this bit is updated after each access the RAHEAD = '1' setting may hide errors.
- 3 DMA active (DMAACT) - '1' if core is currently performing a DMA operation.
- 2 Malfunction (MALF): This bit is set to one by the core is DMA is not finished when a new byte starts getting shifted. If this bit is set to '1' then the last AHB access was not successful.
- 1:0 AMBA access size (HSIZE) - Controls the access size that the core will use for AMBA accesses. 0: byte, 1: half-word, 2: word. HSIZE = "11" is illegal.

Reset value: 0x42

### 43.4.3 Read and write instructions (WRITE and READ/READD)

The READD is the same as the READ instruction with an additional dummy byte inserted after the four address bytes. To perform a read operation on AHB via the SPI bus the following sequence should be performed:

1. Assert slave select
2. Send READ instruction
3. Send four byte AMBA address, the most significant byte is transferred first
- 3a. Send dummy byte (if READD is used)
4. Read the wanted number of data bytes
5. De-assert slave select

To perform a write access on AHB via the SPI bus, use the following sequence:

1. Assert slave select
2. Send WRITE instruction
3. Send four byte AMBA address, the most significant byte is transferred first
4. Send the wanted number of data bytes
5. De-assert slave select

During consecutive read or write operations, the core will automatically increment the address. The access size (byte, halfword or word) used on AHB is set via the HSIZE field in the SPI status/control register.

The core always respects the access size specified via the HSIZE field. If a write operation writes fewer bytes than what is required to do an access of the specified HSIZE then the write data will be dropped, no access will be made on AHB. If a read operation reads fewer bytes than what is specified by HSIZE then the remaining read data will be dropped when slave select is de-asserted.

The core will not mask any address bits. Therefore it is important that the SPI master respects AMBA rules when performing half-word and word accesses. A half-word access must be aligned on a two byte address boundary (least significant bit of address must be zero) and a word access must be aligned on a four byte boundary (two least significant address bits must be zero).

### 43.4.4 Memory protection

Default configuration allows full access to the complete AHB address range. The access range can be restricted via configuration registers.

The registers PADDR and PMASK are used to assign the memory protection area's address and mask in the following way:

Protection	address,	bits	31:16	(PADDR[31:16]):	ahbaddrh
Protection	address,	bits	15:0	(PADDR[15:0]):	ahbaddrl

# LEON3FT Microcontroller

Protection mask, bits 31:16 (PMASK[31:16]): ahbmaskh  
 Protection mask, bits 15:0 (PMASK[15:0]): ahbmaskl

Before the core performs an AMBA access it will perform the check:

$$(((incoming\ address)\ xor\ (protaddr))\ and\ protmask) \neq 0x00000000$$

If the above expression is true (one or several bits in the incoming address differ from the protection address, and the corresponding mask bits are set to ‘1’) then the access is inhibited. As an example, assume that *protaddr* is 0xA0000000 and *protmask* is 0xF0000000. Since *protmask* only has ones in the most significant nibble, the check above can only be triggered for these bits. The address range of allowed accessed will thus be 0xA0000000 - 0xAFFFFFFF..

The core will set the configuration register bit PROT if an access is attempted outside the allowed address range. This bit is updated on each AHB access and will be cleared by an access inside the allowed range.

## 43.5 Registers

The core is programmed through registers mapped into APB address space.

Table 565. APB registers

APB address offset	Register
0x00	Control register
0x04	Status register
0x08	Protection address register
0x0C	Protection mask register

# LEON3FT Microcontroller

## 43.5.1 Control Register

Table 566.0x00 - CTRL - Control register

31	RESERVED	2	1	0
	0		IRQEN	EN
	r		0	1
			rw	rw

- 31 : 2      RESERVED
- 1          Interrupt enable (IRQEN) - When this bit is set to '1' the core will generate an interrupt each time the DMA field in the status register transitions from '0' to '1'.
- 0          Core enable (EN) - When this bit is set to '1' the core is enabled and will respond to SPI accesses. Otherwise the core will not react to SPI traffic.

## 43.5.2 Status Register

Table 567.0x04 - STAT - Status register

31	RESERVED	3	2	1	0
	0		PROT	WR	DMA
	r		0	0	0
			wc	r	wc

- 31 : 3      RESERVED
- 2          Protection triggered (PROT) - Set to '1' if an access has triggered the memory protection. This bit will remain set until cleared by writing '1' to this position. Note that the other fields in this register will be updated on each AHB access while the PROT bit will remain at '1' once set.
- 1          Write access (WR) - Last AHB access performed was a write access. This bit is read only.
- 0          Direct Memory Access (DMA) - This bit gets set to '1' each time the core attempts to perform an AHB access. By setting the IRQEN field in the control register this condition can generate an interrupt. This bit can be cleared by software by writing '1' to this position.

## 43.5.3 Protection Address Register

Table 568.0x08 - PADDR - Protection address register

31	PROTADDR	0
	0x0	
	rw	

- 31 : 0      Protection address (PROTADDR) - Defines the base address for the memory area where the core is allowed to make accesses.

## 43.5.4 Protection Mask Register

Table 569.0x0C - PMASK - Protection mask register

31	PROTMASK	0
	0x0	
	rw	

- 31 : 0      Protection mask (PROTMASK) - Selects which bits in the Protection address register that are used to define the protected memory area.

# LEON3FT Microcontroller

## 44 SPI Controller

The GR716 microcontroller comprises two separate SPI controller (SPICTRL) units. Each SPI controller unit controls its own external pins and has a unique AMBA address described in chapter 2.10.

Each SPI controller unit control and status registers are located on the APB bus in the address range from 0x80390000 to 0x803AFFFF. See SPICTRL units connections in the next drawing. The figure shows memory locations and functions used for SPICTRL configuration and control.

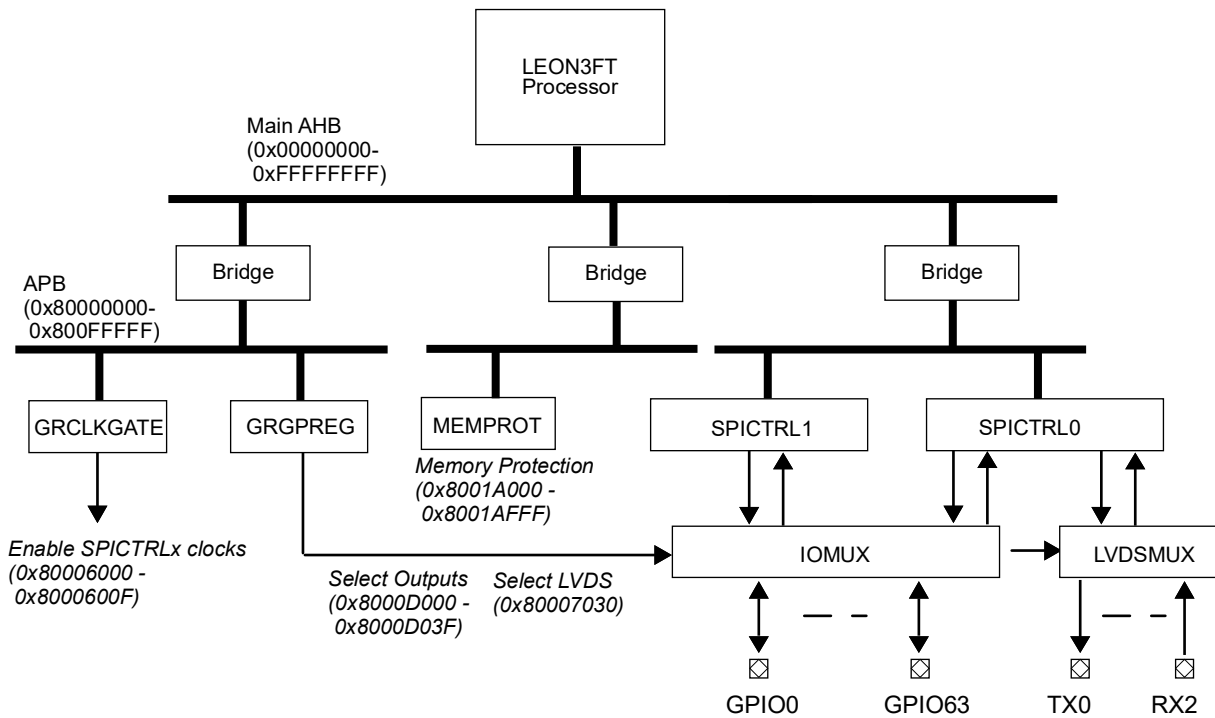


Figure 84. GR716 SPICTRLx bus and pin

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable SPI controller units. The unit **GRCLKGATE** can also be used to perform reset of individual SPI controller units. Software must enable clock and release reset described in section 27 before SPI configuration and transmission can start.

External IO selection per SPI controller unit is made in the system IO and LVDS configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F and 0x80007030. See section 7.1 for further information.

Each **SPICTRLx** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. SPICTRL unit 0 and 1 has identical configuration and status registers. Configuration and status registers are described in this section 44.3

System can be configured to protect and restrict access to individual SPICTRL unit in the **MEMPROT** unit. See section 47 for more information.

### 44.1 Overview

The core provides a link between the AMBA APB bus and the Serial Peripheral Interface (SPI) bus and can be dynamically configured to function either as a SPI master or a slave. The SPI bus parameters are highly configurable via registers. Core features also include configurable word length, bit



# LEON3FT Microcontroller

ordering, clock gap insertion, automatic slave select and automatic periodic transfers of a specified length. All SPI modes are supported and also a 3-wire mode where one bidirectional data line is used. In slave mode the core synchronizes the incoming clock and can operate in systems where other SPI devices are driven by asynchronous clocks.

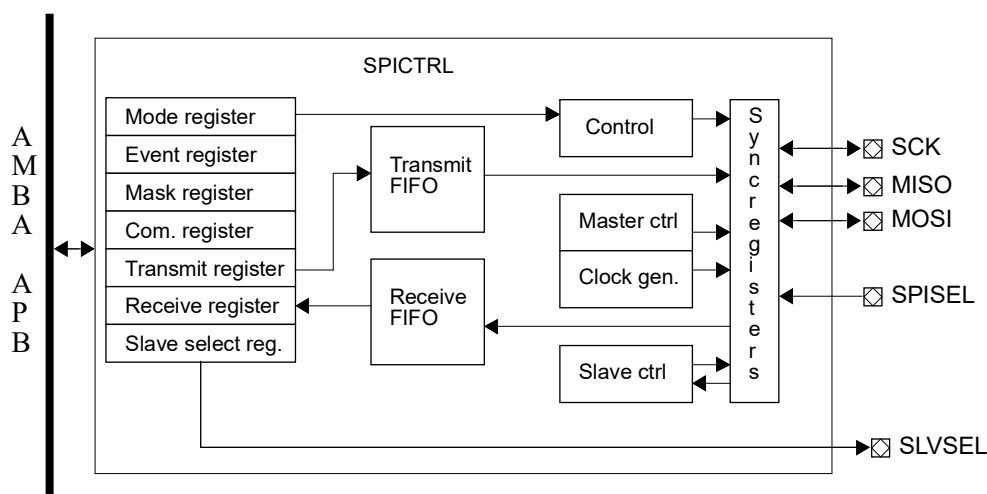


Figure 85. Block diagram

## 44.2 Operation

### 44.2.1 SPI transmission protocol

The SPI bus is a full-duplex synchronous serial bus. Transmission starts when a master selects a slave through the slave's Slave Select (SLVSEL) signal and the clock line SCK transitions from its idle state. Data is transferred from the master through the Master-Output-Slave-Input (MOSI) signal and from the slave through the Master-Input-Slave-Output (MISO) signal. In a system with only one master and one slave, the Slave Select input of the slave may be always active and the master does not need to have a slave select output. If the core is configured as a master it will monitor the SPISEL signal to detect collisions with other masters, if SPISEL is activated the master will be disabled.

During a transmission on the SPI bus data is either changed or read at a transition of SCK. If data has been read at edge  $n$ , data is changed at edge  $n+1$ . If data is read at the first transition of SCK the bus is said to have clock phase 0, and if data is changed at the first transition of SCK the bus has clock phase 1. The idle state of SCK may be either high or low. If the idle state of SCK is low, the bus has clock polarity 0 and if the idle state is high the clock polarity is 1. The combined values of clock polarity (CPOL) and clock phase (CPHA) determine the mode of the SPI bus. Figure 86 shows one byte (0x55) being transferred MSb first over the SPI bus under the four different modes. Note that the idle state of the MOSI line is '1' and that CPHA = 0 means that the devices must have data ready before the first transition of SCK. The figure does not include the MISO signal, the behavior of this line is the same as for the MOSI signal. However, due to synchronization issues the MISO signal will be delayed when the core is operating in slave mode, please see section 44.2.5 for details.

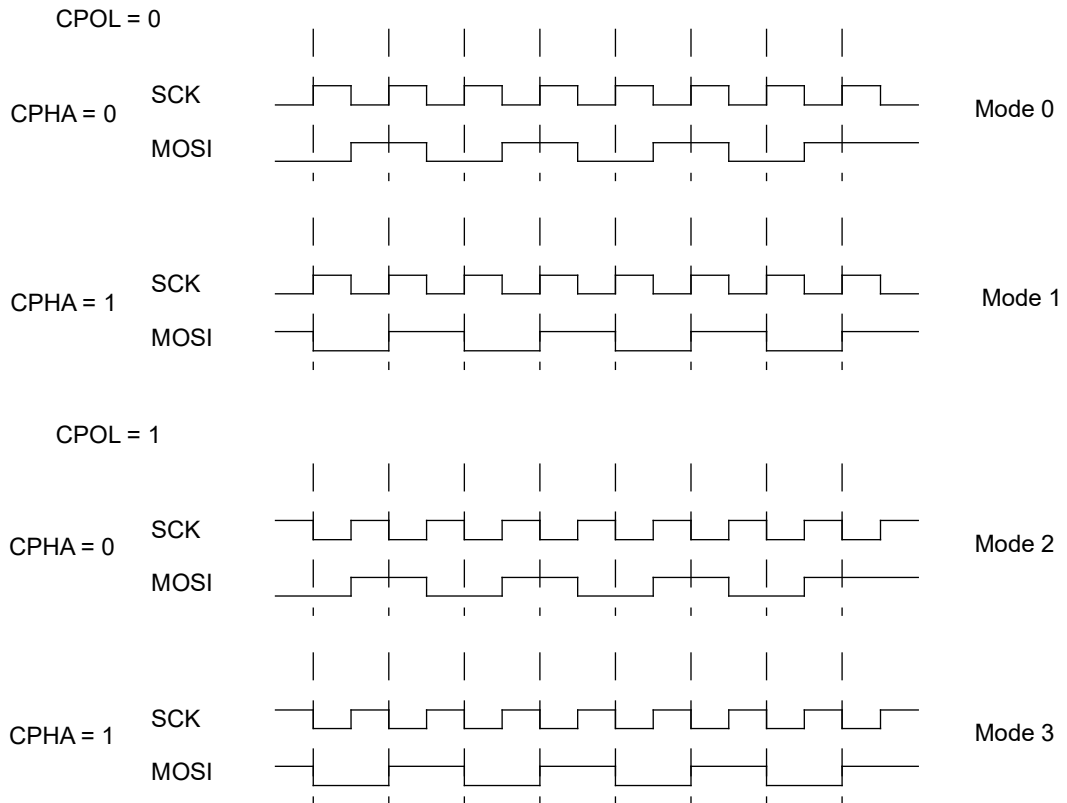


Figure 86. SPI transfer of byte 0x55 in all modes

### 44.2.2 3-wire transmission protocol

The core can be configured to operate in 3-wire mode, if the TWEN field in the core’s Capability register is set to ‘1’, where the controller uses a bidirectional dataline instead of separate data lines for input and output data. In 3-wire mode the bus is thus a half-duplex synchronous serial bus. Transmission starts when a master selects a slave through the slave’s Slave Select (SLVSEL) signal and the clock line SCK transitions from its idle state. Only the Master-Output-Slave-Input (MOSI) signal is used for data transfer in 3-wire mode. The MISO signal is not used.

The direction of the first data transfer is determined by the value of the 3-wire Transfer Order (TTO) field in the core’s Mode register. If TTO is ‘0’, data is first transferred from the master (through the MOSI signal). After a word has been transferred, the slave uses the same data line to transfer a word back to the master. If TTO is ‘1’ data is first transferred from the slave to the master. After a word has been transferred, the master uses the MOSI line to transfer a word back to the slave.

The data line transitions depending on the clock polarity and clock phase in the same manner as in SPI mode. The aforementioned slave delay of the MISO signal in SPI mode will affect the MOSI signal in 3-wire mode, when the core operates as a slave.

### 44.2.3 Receive and transmit queues

The core’s transmit queue consists of the transmit register and the transmit FIFO. The receive queue consists of the receive register and the receive FIFO. The total number of words that can exist in each queue is thus the FIFO depth plus one. When the core has one or more free slots in the transmit queue it will assert the Not full (NF) bit in the event register. Software may only write to the transmit register when this bit is asserted. When the core has received a word, as defined by word length (LEN) in the Mode register, it will place the data in the receive queue. When the receive queue has one or more elements stored the Event register bit Not empty (NE) will be asserted. The receive register will only contain valid data if the Not empty bit is asserted and software should not access the receive register

# LEON3FT Microcontroller

unless this bit is set. If the receive queue is full and the core receives a new word, an overrun condition will occur. The received data will be discarded and the Overrun (OV) bit in the Event register will be set.

The core will also detect underrun conditions. An underrun condition occurs when the core is selected, via SPISEL, and the SCK clock transitions while the transmit queue is empty. In this scenario the core will respond with all bits set to '1' and set the Underrun (UN) bit in the Event register. An underrun condition will never occur in master mode. When the master has an empty transmit queue the bus will go into an idle state.

## 44.2.4 Clock generation

The core only generates the clock in master mode, the generated frequency depends on the system clock frequency and the Mode register fields DIV16, FACT, and PM. Without DIV16 the SCK frequency is:

$$SCKFrequency = \frac{AMBAclockfrequency}{(4 - (2 \cdot FACT)) \cdot (PM + 1)}$$

With DIV16 enabled the frequency of SCK is derived through:

$$SCKFrequency = \frac{AMBAclockfrequency}{16 \cdot (4 - (2 \cdot FACT)) \cdot (PM + 1)}$$

Note that the fields of the Mode register, which includes DIV16, FACT and PM, should not be changed when the core is enabled. If the FACT field is set to 0 the core's register interface is compatible with the register interface found in MPC83xx SoCs. If the FACT field is set to 1, the core can generate an SCK clock with higher frequency.

## 44.2.5 Slave operation

When the core is configured for slave operation it does not drive any SPI signal until the core is selected, via the SPISEL input, by a master. If the core operates in SPI mode when SPISEL goes low the core configures MISO as an output and drives the value of the first bit scheduled for transfer. If the core is configured into 3-wire mode the core will first listen to the MOSI line and when a word has been transferred drive the response on the MOSI line. If the core is selected when the transmit queue is empty it will transfer a word with all bits set to '1' and the core will report an underflow.

Since the core synchronizes the incoming clock it will not react to transitions on SCK until two system clock cycles have passed. This leads to a delay of three system clock cycles when the data output line should change as the result of a SCK transition. This constrains the maximum input SCK frequency of the slave to (system clock) / 8 or less. The controlling master must also allow the decreased setup time on the slave data out line.

The core can also filter the SCK input. The value of the PM field in the Mode register defines for how many system clock cycles the SCK input must be stable before the core accepts the new value. If the PM field is set to zero, then the maximum SCK frequency of the slave is, as stated above, (system clock) / 8 or less. For each increment of the PM field the clock period of SCK must be prolonged by two times the system clock period as the core will require longer time discover and respond to SCK transitions.

## 44.2.6 Master operation

When the core is configured for master operation it will transmit a word when there is data available in the transmit queue. When the transmit queue is empty the core will drive SCK to its idle state. If the

# LEON3FT Microcontroller

SPISEL input goes low during master operation the core will abort any active transmission and the Multiple-master error (MME) bit will be asserted in the Event register. If a Multiple-master error occurs the core will be disabled. Note that the core will react to changes on SPISEL even if the core is operating in loop mode and that the core can be configured to ignore SPISEL by setting the IGSEL field in the Mode register.

## 44.3 Registers

The core is programmed through registers mapped into APB address space.

Table 570. SPI controller registers

APB address offset	Register
0x00	Capability register
0x04-0x1C	Reserved
0x20	Mode register
0x24	Event register
0x28	Mask register
0x2C	Command register
0x30	Transmit register
0x34	Receive register
0x38	Slave Select register
0x3C	Automatic slave select register

# LEON3FT Microcontroller

## 44.3.1 SPI Controller Capability Register

Table 571.0x00 - CAP - SPI controller Capability register

31	24	23	20	19	18	17	16
SSSZ		MAXWLEN		TWEN	R	ASELA	SSEN
4		0x0		1	0	1	1
r		r		r	r	r	r
15	8	7	6	5	4	0	
FDEPTH		SR	FT	REV			
0x10		0	0x0	5			
r		r	r	r			

- 31 : 24 Slave Select register size (SSSZ) - Number of slave select signals supported.
- 23 : 20 Maximum word Length (MAXWLEN) - The maximum word length supported is 32-bits
- 19 Three-wire mode Enable (TWEN)
- 18 Reserved
- 17 Automatic slave select available (ASELA)
- 16 Slave Select Enable (SSEN) - Multiple slave selects
- 15 : 8 FIFO depth (FDEPTH) - This field contains the depth of the core's internal FIFOs.
- 7 SYNCRAM (SR) - Core has buffers implemented with SYNCRAM components.
- 6 : 5 Fault-tolerance (FT) - Not used
- 4 : 0 Core revision (REV) - This manual applies to core revision 5.

## 44.3.2 SPI Controller Mode Register

Table 572.0x20 - MODE - SPI controller Mode register

31	30	29	28	27	26	25	24	23	20	19	16			
R	LOOP	CPOL	CPHA	DIV16	REV	MS	EN	LEN		PM				
0	0	0	0	0	0	0	0	0		0				
r	rw	rw	rw	rw	rw	rw	rw	rw		rw				
15	14	13	12	11	7			6	5	4	3	2	1	0
TWEN		ASEL	FACT	OD	CG			ASELDEL	TAC	TTO	IGSEL	CITE	R	
0		0	0	0	0			0	0	0	0	*	0	
rw*		rw*	rw	rw*	rw			rw*	rw	rw	rw	rw	r	

- 31 Reserved
- 30 Loop mode (LOOP) - When this bit is set, and the core is enabled, the core's transmitter and receiver are interconnected and the core will operate in loopback mode. The core will still detect, and will be disabled, on Multiple-master errors.
- 29 Clock polarity (CPOL) - Determines the polarity (idle state) of the SCK clock.
- 28 Clock phase (CPHA) - When CPHA is '0' data will be read on the first transition of SCK. When CPHA is '1' data will be read on the second transition of SCK.
- 27 Divide by 16 (DIV16) - Divide system clock by 16, see description of PM field below and see section 44.2.4 on clock generation. This bit has no significance in slave mode.
- 26 Reverse data (REV) - When this bit is '0' data is transmitted LSB first, when this bit is '1' data is transmitted MSB first. This bit affects the layout of the transmit and receive registers.
- 25 Master/Slave (MS) - When this bit is set to '1' the core will act as a master, when this bit is set to '0' the core will operate in slave mode.
- 24 Enable core (EN) - When this bit is set to '1' the core is enabled. No fields in the mode register should be changed while the core is enabled. This can bit can be set to '0' by software, or by the core if a multiple-master error occurs.

# LEON3FT Microcontroller

Table 572.0x20 - MODE - SPI controller Mode register

23 : 20	<p>Word length (LEN) - The value of this field determines the length in bits of a transfer on the SPI bus. Values are interpreted as:</p> <p>0b0000 - 32-bit word length</p> <p>0b0001-0b0010 - Illegal values</p> <p>0b0011-0b1111 - Word length is LEN+1, allows words of length 4-16 bits.</p> <p>The value of this field must never specify a word length that is greater than the maximum allowed word length specified by the MAXWLEN field in the Capability register.</p>
19 : 16	<p>Prescale modulus (PM) - This value is used in master mode to divide the system clock and generate the SPI SCK clock. The value in this field depends on the value of the FACT bit.</p> <p>If bit 13 (FACT) is '0': The system clock is divided by <math>4*(PM+1)</math> if the DIV16 field is '0' and <math>16*4*(PM+1)</math> if the DIV16 field is set to '1'. The highest SCK frequency is attained when PM is set to 0b0000 and DIV16 to '0', this configuration will give a SCK frequency that is (system clock)/4. With this setting the core is compatible with the SPI register interface found in MPC83xx SoCs.</p> <p>If bit 13 (FACT) is '1': The system clock is divided by <math>2*(PM+1)</math> if the DIV16 field is '0' and <math>16*2*(PM+1)</math> if the DIV16 field is set to '1'. The highest SCK frequency is attained when PM is set to 0b0000 and DIV16 to '0', this configuration will give a SCK frequency that is (system clock)/2.</p> <p>In slave mode the value of this field defines the number of system clock cycles that the SCK input must be stable for the core to accept the state of the signal. See section 44.2.5.</p>
15	<p>Three-wire mode (TW) - If this bit is set to '1' the core will operate in 3-wire mode. This bit can only be set if the TWEN field of the Capability register is set to '1'.</p>
14	<p>Automatic slave select (ASEL) - If this bit is set to '1' the core will swap the contents in the Slave select register with the contents of the Automatic slave select register when a transfer is started and the core is in master mode. When the transmit queue is empty, the slave select register will be swapped back. Note that if the core is disabled (by writing to the core enable bit or due to a multiple-master-error (MME)) when a transfer is in progress, the registers may still be swapped when the core goes idle. This bit can only be set if the ASELA field of the Capability register is set to '1'. Also see the ASELDEL field which can be set to insert a delay between the slave select register swap and the start of a transfer.</p>
13	<p>PM factor (FACT) - If this bit is 1 the core's register interface is no longer compatible with the MPC83xx register interface. The value of this bit affects how the PM field is utilized to scale the SPI clock. See the description of the PM field.</p>
12	<p>Open drain mode (OD) - If this bit is set to '0', all pins are configured for operation in normal mode. If this bit is set to '1' all pins are set to open drain mode. The implementation of the core may or may not support open drain mode. If this bit can be set to '1' by writing to this location, the core supports open drain mode. The pins driven from the slave select register are not affected by the value of this bit.</p>
11 : 7	<p>Clock gap (CG) - The value of this field is only significant in master mode. The core will insert CG SCK clock cycles between each consecutive word. This only applies when the transmit queue is kept non-empty. After the last word of the transmit queue has been sent the core will go into an idle state and will continue to transmit data as soon as a new word is written to the transmit register, regardless of the value in CG. A value of 0b00000 in this field enables back-to-back transfers.</p>
6 : 5	<p>Automatic Slave Select Delay (ASELDEL) - If the core is configured to use automatic slave select (ASEL field set to '1') the core will insert a delay corresponding to <math>ASELDEL*(SPI\ SCK\ cycle\ time)/2</math> between the swap of the slave select registers and the first toggle of the SCK clock. As an example, if this field is set to "10" the core will insert a delay corresponding to one SCK cycle between assigning the Automatic slave select register to the Slave select register and toggling SCK for the first time in the transfer. This field can only be set if the ASELA field of the Capability register is set to '1'.</p>
4	<p>Toggle Automatic slave select during Clock Gap (TAC) - If this bit is set, and the ASEL field is set, the core will perform the swap of the slave select registers at the start and end of each clock gap. The clock gap is defined by the CG field and must be set to a value <math>\geq 2</math> if this field is set. This field can only be set if the ASELA field of the Capability register is set to '1'.</p>
3	<p>3-wire Transfer Order (TTO) - This bit controls if the master or slave transmits a word first in 3-wire mode. If this bit is '0', data is first transferred from the master to the slave. If this bit is '1', data is first transferred from the slave to the master. This bit can only be set if the TWEN field of the Capability register is set to '1'.</p>
2	<p>Ignore SPISEL input (IGSEL) - If this bit is set to '1' then the core will ignore the value of the SPISEL input.</p>

# LEON3FT Microcontroller

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Table 572.0x20 - MODE - SPI controller Mode register

1	Require Clock Idle for Transfer End (CITE) - If this bit is '0' the core will regard the transfer of a word as completed when the last bit has been sampled. If this bit is set to '1' the core will wait until it has set the SCK clock to its idle level (see CI field) before regarding a transfer as completed. This setting only affects the behavior of the TIP status bit, and automatic slave select toggling at the end of a transfer, when the clock phase (CP field) is '0'.
0	RESERVED (R) - Read as zero and should be written as zero to ensure forward compatibility.

# LEON3FT Microcontroller

## 44.3.3 SPI Controller Event Register

Table 573.0x24 - EVENT - SPI controller Event register

31	30	16	15	14	13	12	11	10	9	8	7	0
TIP	R		AT	LT	R	OV	UN	MME	NE	NF		R
0	0		0	0	0	0	0	0	0	1		0
r	r		r	wc	r	wc	wc	wc	r	r		r

- 31            Transfer in progress (TIP) - This bit is '1' when the core has a transfer in progress. Writes have no effect. This bit is set when the core starts a transfer and is reset to '0' once the core considers the transfer to be finished. Behavior affected by setting of CITE field in Mode register.
- 30 : 16      RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 15            Automated transfers (AT) - Not used
- 14            Last character (LT) - This bit is set when a transfer completes if the transmit queue is empty and the LST bit in the Command register has been written. This bit is cleared by writing '1', writes of '0' have no effect.
- 13            RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 12            Overrun (OV) - This bit gets set when the receive queue is full and the core receives new data. The core continues communicating over the SPI bus but discards the new data. This bit is cleared by writing '1', writes of '0' have no effect.
- 11            Underrun (UN) - This bit is only set when the core is operating in slave mode. The bit is set if the core's transmit queue is empty when a master initiates a transfer. When this happens the core will respond with a word where all bits are set to '1'. This bit is cleared by writing '1', writes of '0' have no effect.
- 10            Multiple-master error (MME) - This bit is set when the core is operating in master mode and the SPI-SEL input goes active. In addition to setting this bit the core will be disabled. This bit is cleared by writing '1', writes of '0' have no effect.
- 9             Not empty (NE) - This bit is set when the receive queue contains one or more elements. It is cleared automatically by the core, writes have no effect.
- 8             Not full (NF) - This bit is set when the transmit queue has room for one or more words. It is cleared automatically by the core when the queue is full, writes have no effect.
- 7 : 0        RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.



# LEON3FT Microcontroller

## 44.3.4 SPI Controller Mask Register

Table 574.0x28 - MASK - SPI controller Mask register

31	30	16	15	14	13	12	11	10	9	8	7	0
TIPE	R		AT	LTE	R	OVE	UNE	MMEE	NEE	NFE		R
0	0		0	0	0	0	0	0	0	0		0
rw	r		rw	rw	rw	rw	rw	rw	rw	rw		r

- 31            Transfer in progress enable (TIPE) - When this bit is set the core will generate an interrupt when the TIP bit in the Event register transitions from '0' to '1'.
- 30 : 16      RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 15            Automated transfers (AT) - Not used and should be always be set to '0'
- 14            Last character enable (LTE) - When this bit is set the core will generate an interrupt when the LT bit in the Event register transitions from '0' to '1'.
- 13            RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 12            Overrun enable (OVE) - When this bit is set the core will generate an interrupt when the OV bit in the Event register transitions from '0' to '1'.
- 11            Underrun enable (UNE) - When this bit is set the core will generate an interrupt when the UN bit in the Event register transitions from '0' to '1'.
- 10            Multiple-master error enable (MMEE) - When this bit is set the core will generate an interrupt when the MME bit in the Event register transitions from '0' to '1'.
- 9             Not empty enable (NEE) - When this bit is set the core will generate an interrupt when the NE bit in the Event register transitions from '0' to '1'.
- 8             Not full enable (NFE) - When this bit is set the core will generate an interrupt when the NF bit in the Event register transitions from '0' to '1'.
- 7 : 0        RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.

## 44.3.5 SPI Controller Command Register

Table 575.0x2C - CMD - SPI controller Command register

31	23	22	21	0
	R	LST		R
	0	0		0
	r	rw		r

- 31 : 23      RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 22            Last (LST) - After this bit has been written to '1' the core will set the Event register bit LT when a character has been transmitted and the transmit queue is empty. If the core is operating in 3-wire mode the Event register bit is set when the whole transfer has completed. This bit is automatically cleared when the Event register bit has been set and is always read as zero.
- 21 : 0        RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.

## 44.3.6 SPI Controller Transmit Register

Table 576.0x30 - TX - SPI controller Transmit register

31	0
	TDATA
	0
	w

- 31 : 0        Transmit data (TDATA) - Writing a word into this register places the word in the transmit queue. This register will only react to writes if the Not full (NF) bit in the Event register is set.

# LEON3FT Microcontroller

## 44.3.7 SPI Controller Receive Register

Table 577.0x34 - RXC - SPI controller Receive register

31	RDATA	0
	0	
	r	

31 : 0 Receive data (RDATA) - This register contains valid receive data when the Not empty (NE) bit of the Event register is set. The placement of the received word depends on the Mode register fields LEN and REV:

For LEN = 0b0000 - The data is placed with its MSb in bit 31 and its LSb in bit 0.

For other lengths and REV = '0' - The data is placed with its MSB in bit 15.

For other lengths and REV = '1' - The data is placed with its LSB in bit 16.

To illustrate this, a transfer of a word with eight bits (LEN = 7) that are all set to one will have the following placement:

REV = '0' - 0x0000FF00

REV = '1' - 0x00FF0000

## 44.3.8 SPI Slave Select Register

Table 578.0x38 - SLVSEL - SPI Slave select register (optional)

31	R	4	3	0
	0			SLVSEL
	r			0xF
				rw

31 : 4 RESERVED (R) - Not used

3 : 0 Slave select (SLVSEL) - Slave select signals are mapped to this register on bits 3:0. Software is solely responsible for activating the correct slave select signals, the core does not assert or deassert any slave select signal automatically.

## 44.3.9 SPI Controller Automatic Slave Select Register

Table 579.0x3C - ASLVSEL - SPI controller Automatic slave select register

31	R	4	3	0
	0			ASLVSEL
	r			0
				rw

31 : 4 RESERVED (R)

3 : 0 Automatic Slave select (ASLVSEL) - If SSEN and ASELA in the Capability register are both '1' the core's slave select signals are assigned from this register when the core is about to perform a transfer and the ASEL field in the Mode register is set to '1'. After a transfer has been completed the core's slave select signals are assigned the original value in the slave select register.

# LEON3FT Microcontroller

## 45 SPI for Space Slave Controller

The GR716 microcontroller comprises an SPI for Space Slave controller (SPI4S). The SPI for Space Slave controller controls its own external pins and has a unique AMBA address described in chapter 2.10. The nominal SPI for Space Slave interface is connected via LVDS transceivers to external pins and the redundant interface is connected to external pins via the IOMUX.

The control and status register are located on APB bus in the address range from 0x8040E000 to 0x8040EFFF. See SPI for Space Slave controller connections in the next drawing. The figure shows memory locations and functions used for SPI4S configuration and control.

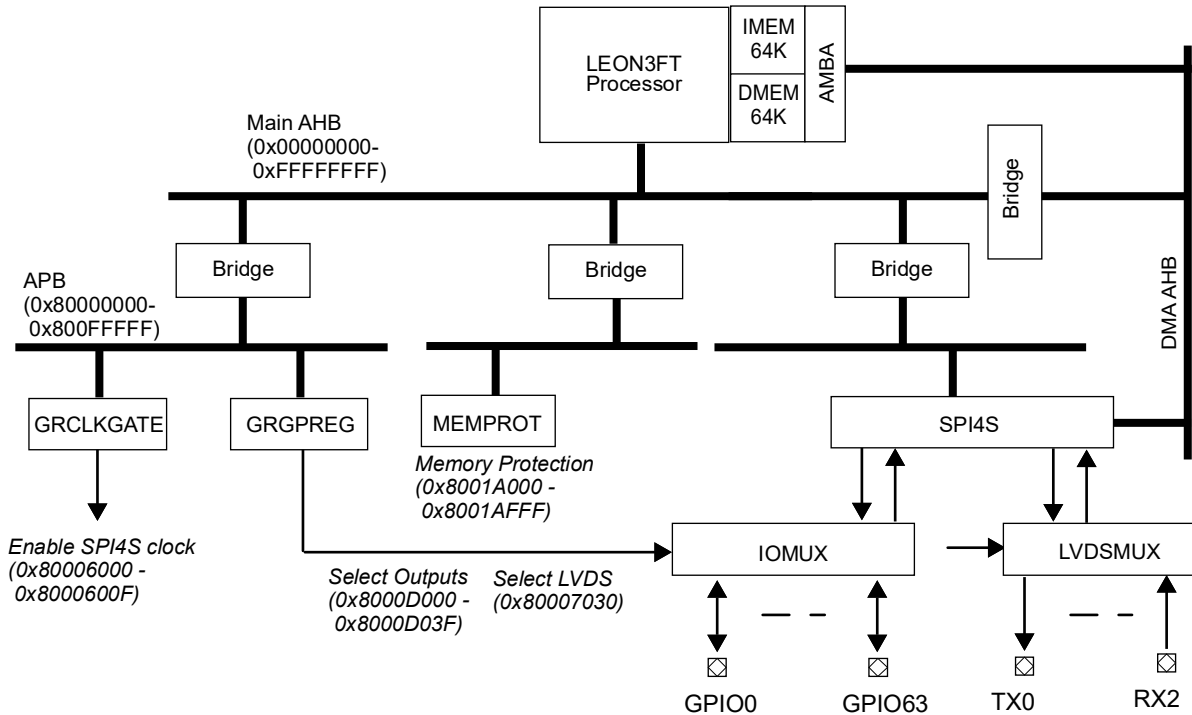


Figure 87. GR716 SPI4S bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the SPI for Space Slave controller. The unit **GRCLKGATE** can also be used to perform reset of the SPI for Space Slave controller. Software must enable clock and release reset described in section 27 before configuration and transmission can start.

External IO selection and configuration is made in the system IO and LVDS configuration registers (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F and 0x80007030. See section 7.1 for further information.

The system can be configured to protect and restrict access to the SPI for Space Slave controller in the **MEMPROT** unit. See section 47 for more information.

### 45.1 Overview

This core is a Dual Port SPI Slave device that provides link between SPI and AMBA AHB and APB ports. Core features include configurable word length (4, 5, 6 ... 32 bits), bit ordering and all four SPI modes are supported. This core also has redundant SPI ports which can be interfaced using two different masters. The slave takes two sets of SPI interfaces (nominal and redundant each consists of two data signals, one clock signal and one chip select signal).

# LEON3FT Microcontroller

## 45.2 Implementation of SPI protocols

In order to support the SPI 0 protocol the slave provides configurable word length of 4, 5, 6 ... 32 bits transmission and reception. The Word bit ordering can be MSB first or LSB first transferred.

For SPI 1 protocol the word length of the transfer can be 8, 16 or 24 bits. The word bit ordering MSB transferred first and LSB transferred last is supported. The parity bit can be appended at the end of every word, the parity bit is not included by the SPI slave device, since the implementation supports 9, 17 and 25 bits of word transfer the parity bit can be appended by the software.

All control and data transfer for SPI protocol 0 and 1 are supported only through the APB registers.

The SPI protocol 2 uses a fixed word length of 16 bits. The word bit ordering is MSB transferred first and LSB transferred last. Also this core implements the network layer of the SPI protocol 2, the slave hardware itself can process the SPI protocol 2 commands and provide responses. The APB interface is only for control and status, all the data transfer to the AMBA is performed using the AHB Master.

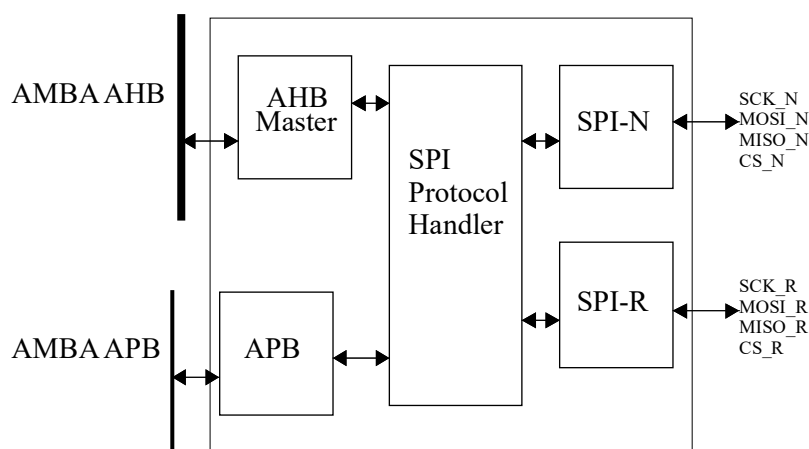


Figure 88. Block diagram

## 45.3 Transmission

The SPI bus is a full-duplex synchronous serial bus. Transmission starts when a master selects a slave through the slave's Slave Select (CS) signal and the clock line SCK transitions from its idle state. Data is transferred from the master through the Master-Output-Slave-Input (MOSI) signal and from the slave through the Master-Input-Slave-Output (MISO) signal. In some systems with only one master and one slave, the Slave Select input of the slave may be always active and the master does not need to have a slave select output. This does not apply to this device, the slave select signal must be used to mark the start and end of an operation.

During a transmission on the SPI bus data is either changed or read at a transition of SCK. If data has been read at edge  $n$ , data is changed at edge  $n+1$ . If data is read at the first transition of SCK the bus is said to have clock phase 0, and if data is changed at the first transition of SCK the bus has clock phase 1. The idle state of SCK may be either high or low. If the idle state of SCK is low, the bus has clock polarity 0 and if the idle state is high the clock polarity is 1. The combined values of clock polarity (CPOL) and clock phase (CPHA) determine the mode of the SPI bus. Figure below shows one byte (0x55) being transferred MSb first over the SPI bus under the four different modes. Note that the idle state of the MOSI line is '1' and that CPHA = 0 means that the devices must have data ready before

# LEON3FT Microcontroller

the first transition of SCK. The figure does not include the MISO signal, the behavior of this line is the same as for the MOSI signal.

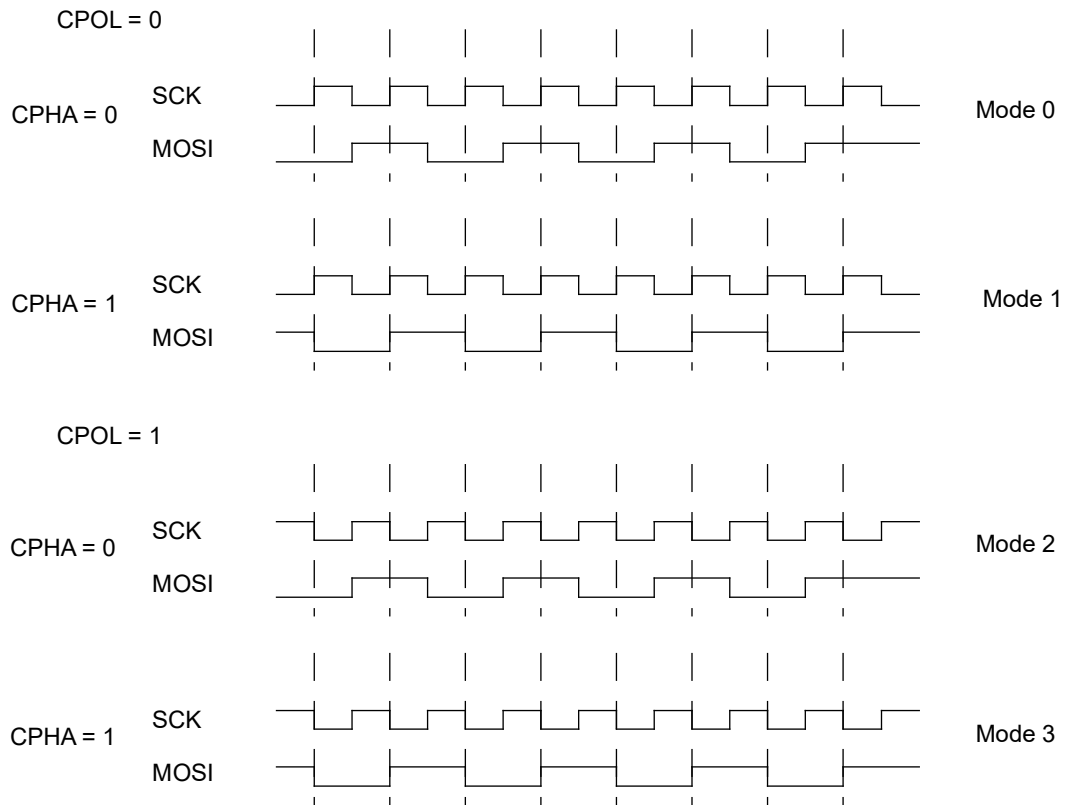


Figure 89. SPI transfer of byte 0x55 in all modes

## 45.4 Operation

The data transfer between the master and the slave is through APB registers or through command transfer from a master is determined by the EN bit in the SPI2 control register. When APB registers are used the data transferred by a master is available at receive registers (NRDATA or RRDATA depending on the port used) while during the same reception period the contents of the transmit registers (TDATA) are transferred to the master. When appropriate commands are transferred by a master SPI device and EN bit in the SPI2 control register is enabled then the commands are processed by the SPI 2 protocol handler available in this core. The SPI protocol 2 implementation is explained in detail in the following section.

## 45.5 SPI 2 Protocol Handler

The core is capable of handling the commands (based on SPI protocol 2) transferred by a SPI master and provide response. The message format transferred between a SPI master and SPI slave device is defined below.

Table 580. Example message format (write data)

Signal	Message Header		Payload	Payload CRC
MOSI	Command #1	Command #2	Data	CRC-16
MISO	Response #1	Response #2	0x0000	0x0000

# LEON3FT Microcontroller

Table 581. Example message format (read data)

Signal	Message Header		Payload	Payload CRC
MOSI	Command #1	Command #2	0x0000	0x0000
MISO	Response #1	Response #2	Data	CRC-16

The message header is composed of a Command token from the master and a Response token from the slave. The message also contains optional data words and CRC checksum appended at the end that are calculated for the data words transferred. The CRC is mandatory, if the message contains payload data then the message is always appended with one word of CRC. The received messages are processed by the SPI slave device and response and data are transferred as per the received command. Also note some of the status bits inplatform

the response token are status for the previously received command.

## 45.6 Message Header - Command Token

The master transmits a message header that specifies the action need to be performed in slave. The command token sent by the master device consist of two 16 bit words. The message header content details are explained below.

Table 582. Command word 1

MSB		Command Token Word #1												LSB	
Prefix		Command Code						Spare		Message Length					
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
'0'	'1'	C5	C4	C3	C2	C1	C0	'1'	'1'	L5	L4	L3	L2	L1	L0

Table 583. Command word 2

MSB		Command Token Word #1												LSB	
Prefix		Sub-Address								Spare		CRC-4			
31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
'0'	'1'	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0	'1'	'1'	C3	C2	C1	C0

### Prefix and spare

The prefix bits are transmitted initially. In the command word#1 and #2 the prefix and spare bits have fixed value in the current implementation, these are reserved bits. The spislave receives them and use it for validating the token. If an invalid prefix and spare bits are received then Status illegal command (SIC) status bit is enabled and also transmitted to master as part of the next response token.

### Message Length

The number of payload words that will be transmitted in the current message. The number should not include the command token and the CRC checksum appended at the end of the message.

### Sub-address

This field provide additional sub-address location for write and read commands.

### CRC-4

# LEON3FT Microcontroller

The final four bits of the command token consist of a checksum for all the previous command token bits transmitted in this message. The CRC-4 should be computed for the following 28 bits, Command word #1 (16bits, MSB first sent to the CRC generator) and Command word #2 (excluding this CRC-4 field) (12bits, MSB first sent to the CRC generator). The Prefix and Spare fields are included in the CRC calculation. The generator polynomial used is  $X^4 + X + 1$ . In this SPI slave receiving end the CRC-4 is calculated internally for the received command token, if the calculated CRC-4 does not match the expected value (this field) the corresponding command token is discarded and message error status is enabled and transmitted to master as part of the next response token.

## Payload data

The payload consist of the data need to be transferred from the master to slave. Depending on the command executed the master must include valid data or dummy information in the form of string of zeros. For example the write command have the data to be written as the payload but the read command have dummy information in the form of string of zeros.

## Payload CRC

When a valid payload is delivered in the payload data section of the message a Payload CRC (CRC-16) must be included at the end of the message. The generator polynomial used is  $x^{16} + x^{15} + x^2 + 1$ . When dummy information in the form of string of zeros is included then no Payload CRC need to be attached then the payload CRC field must be all zero (0X0000). In the SPI slave receiving end the CRC-16 is calculated internally for the received payload data, if the calculated CRC-16 does not match the expected value (this field) the corresponding operation with respect to the command is not performed and message error status is enabled and transmitted to master as part of the next response token.

### 45.6.1 Command Code

The command code specify the operating instruction for the receiving slave. The detailed explanation of each command code and its implementation are explained in the table below.

Table 584. Reset Command

Code	Command	Length	Sub-Address	Payload	Description
0x00	RESET_SPI	0x00	0x00	None	This command will reset all the spi slave device registers to the default value except the time registers (TIME1, TIME2) and core enable registers (ENN and ENR)

The RESET\_SPI command resets the SPI slave device to a power up initialized state. The SPI slave resets the system only if it received a valid command. If the prefix and spare bits does not match or if the calculated CRC-4 does not match the expected value then the RESET\_SPI command is discarded.

Time synchronization command

Table 585. Time synchronization command

Code	Command	Length	Sub-Address	Payload	Description
0x07	SYNCH	0x04	0x00	MOSI: <SYNC1> <SYNC2> <SYNC3> <SYNC4> <CRC-16> MISO: <all zeros>	The master must transmit the SYNC command token followed by payload words containing synchronization information for it. These words are copied inside dedicated registers implemented in the SPI slave device after validation.

The time register is of 64 bit in width, the most significant time is transferred first in SYNC1 followed by SYNC2, SYNC3 and SYNC4. The time register roll over when its maximum count is reached. The time is synchronised only when all the words are received and also the command token CRC-4 and data CRC-16 must be valid. All bits are zero at reset. The RESET\_SPI does not reset the time register.

Table 586. Time increment command

Code	Command	Length	Sub-Address	Payload	Description
0x08	TICK	0x00	Used as index for increment.	None	This command is used to advance the timing synchronization register available in the SPI slave device (same register used for the SYNC command)

A valid command increments the implemented time register. The sub address field specify from which bit the time register must increment.

Table 587. Read back sent command

Code	Command	Length	Sub-Address	Payload	Description
0x0A	READBACK	0x02	0x00	MOSI: <all zeros> MISO: <CMDTOKEN> <CRC-16>	The command can be used to verify the correct reception of the previous command. Upon reception of the command the slave respond with the previous command token

The SPI slave device after receiving the READBACK\_CMD send the previous command token transmitted by the SPI master. This command is useful only when some other command (other than



# LEON3FT Microcontroller

RESET\_SPI) was previously transmitted. If the previous command is RESET\_SPI, the SPI master only receives zeros in the payload section of this command.

Table 588. Write Command

Code	Command	Length	Sub-Address	Payload	Description
0x0D	WRITE_SA	Number of words to be written, N	SA	MOSI: <DW1> <DW2> ...<DWN> <CRC-16> MISO: <all zeros>	The command is used to write a certain number of data words into a slave specific Sub Address. Dedicated field of the command token select the payload length and the target SA.

When a valid WRITE\_SA command is received the payload data is stored at the address specified. The address for writing the data is calculated by using the write address register (CONFIG\_WRITE), and sub-address. The CRC-16 is calculated for received words and compared with the received payload CRC, if a data CRC error is detected then message error status is enabled and transmitted to master as part of the next response token.

Table 589. Read command

Code	Command	Length	Sub-Address	Payload	Description
0x0E	READ_SA	Number of words to be read, N	SA	MOSI: <all zeros> MISO: <DW1> <DW2> ...<DWN> <CRC-16>	The command is used to read a certain number of data words into a slave specific Sub Address. Dedicated field of the command token select the payload length and the target SA

When a valid READ\_SA command is received the payload data is transferred from the address specified. The address for reading the data is calculated by using the read address register (CONFIG\_READ), and sub-address. The CRC-16 is calculated for transmitted words and sent as payload CRC by the slave device.

Table 590. Configure address commands

Code	Command	Length	Sub-Address	Payload	Description
0x20	CONFIG- WRITE_ADDR	0x02	0x00	MOSI: <CW1> <CW2> <CRC-16> MISO: <all zeros>	The command can be used to notify the slave about the address to which the data from the master is written, used for WRITE_SA command.
0x21	CONFIG READ_ADDR	0x02	0x00	MOSI: <CR1> <CR2> <CRC-16> MISO: <all zeros>	The command can be used to notify the slave about the address from which the data to the master is read, used for READ_SA command.

# LEON3FT Microcontroller

Dedicated registers for write address and read address is implemented, these registers takes value from this command. The purpose of this register is to access up to 32 bits of address space. The most significant word CW1 (or CR1) contains the most significant bytes of the target address.

Redundancy commands

Table 591. Redundancy commands

Code	Command	Length	Sub-Address	Payload	Description
0x24	ACTIVATE	0x00	0x00	None	The command is used to activate the other slave interface. This command cannot activate the interface in which it is receiving this command.
0x25	DEACTIVATE	0x00	0x00	None	The command is used to deactivate the other slave interface. This command cannot deactivate the interface in which it is receiving this command.

The SPI Slave device has two dedicated interfaces for two masters. The masters can send to its corresponding slave interface to activate or deactivate the other SPI interface. The master device cannot activate or deactivate the same ports on which it is connected, it can only activate or deactivate the other ports.

Initially both the SPI port interfaces are enabled to receive commands, when the communication between the nominal master and slave interface fails then the redundant master can deactivate the nominal interface using its dedicated redundant interface. The redundant master can also activate the nominal interface.

An example switchover scenario from nominal to redundant interface is described in the following text.

The nominal master communicates with its dedicated interface to a slave device, a fault occurred can be detected by the master using several options,

The status received by the master have invalid values (using the response token),

The Read back command sent does not provide appropriate values in the received payload,

Error bits are enabled in the status received by the master (using the response token),

Based on any of the above mentioned fault detection methods the master can send deactivate command in the redundant interface to deactivate the nominal interface of the slave. The master can send Read back sent commands (using redundant) to check if the previous deactivate command was received by the slave and can check the status of the response token as well. After conforming a proper communication has been established the master can use the redundant interface to perform its normal operations.

Any other commands which are not implemented is received then the command token is discarded and Status illegal command (SIC) bit is enabled and also transmitted to master as part of the next response token.

# LEON3FT Microcontroller

## 45.6.2 Message Header -Response Token

The slave transmits a message header which consist of status of module and details of error occurred. The message header sent by SPI slave device is called response token which consist of two 16 bit words. The message header content details are explained below..

Table 592. Response Token Word #1

MSB		Response Token Word #2												LSB	
Prefix		Command Code					Spare					Module State			
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
'0'	'1'	SFT	ME	AR	IC	'0'	'0'	'0'	'0'	'0'	'0'	MS3	MS2	MS1	MS0

Table 593. Response Token Word #3

MSB		Response Token Word #2												LSB	
Prefix		DATA	Spare								CRC-4				
31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
'0'	'1'	SA7	'0'	'0'	'1'	'1'	'1'	'0'	'0'	'0'	'0'	C3	C2	C1	C0

Table 594. Response Status bit

Bit	Identifier	Type	Value	Description	Clear Condition	Comment
13	TERMINAL_FAULT	Error	'0' = no fault '1' = fault	The bit flag a SPI terminal fault condition.	According to the module current state.	In SPI slave device this bit is enabled or disabled by SPI2 control register (STF) using APB.
12	MESSAGE_ERROR	Error	'0' = no fault '1' = fault	This bit is utilized to indicate that the previous message received from the bus master has failed to pass the validity tests.	Always related to the previous command. Reception of a valid command will clear it (with a delay of one command).	This status bit is enabled when the received message fails to pass the command token and payload data CRC checks. The next valid command clears this status bit.
11	ADDRESS_ERROR	Error	'0' = no fault '1' = fault	This bit flag an AMBA error occurred while performing the previous command.	Always related to the previous command. Reception of a valid command will clear it (with a delay of one command)	The SPI slave device uses an AHB master to perform the memory read and write, this bit is enabled when an AHB error is reported.

Table 594. Response Status bit

Bit	Identifier	Type	Value	Description	Clear Condition	Comment
10	ILLEGAL_CMD	Error	'0' = no fault '1' = fault	This bit flag that the previous received command was not compatible with the SPI slave device.	Always related to the previous command. Reception of a valid command will clear it (with a delay of one command)	When the prefix and spare bits in the received command token do not match the intended value or an unimplemented command is received this status bit is enabled. The next valid command clears this status bit

Table 595. Response Module State bits

Bit	Description
3	In the SPI slave device these bits are enabled or disabled by SPI2 control register (MODSTAT) using APB. These bits can be used by Software controlling the slave device to provide additional status to the master.
2	
1	
0	

### 45.7 Redundancy

The SPI slave has a two SPI ports which can be interfaced using two different masters. The slave takes two sets of SPI interfaces (nominal and redundant). The configuration registers available in the device is used to enable which interface to communicate and it is possible to use dedicated commands (using SPI 2 protocol) to activate and deactivate ports. While using configuration registers to activate or deactivate ports, the complete control of activation and deactivation must be performed by the external unit, only one port is active at any time. When commands are used to control the ports, the device can receive commands from both the interfaces. By receiving from both the interfaces the slave device can deactivate a non-working interface. The intention is to keep only one bus active for normal operation but using the redundant bus to achieve switchover. The SPI protocol 2 implementation supports dedicated commands to achieve the activation and deactivation of interfaces.

# LEON3FT Microcontroller

## 45.8 Registers

The core is programmed through registers mapped into APB address space.

Table 596. APB registers

APB address offset	Register
0x00	Control register
0x04	Status register
0x08	Transmit register
0x0C	Nominal receive register
0x10	Redundant receive register
0x14	Interrupt enable register
0x18	Interrupt register
0x1C	Reserved
0x20	SPI2 control register
0x24	SPI2 time1 register
0x28	SPI2 time2 register
0x2C	SPI2 config address write register
0x30	SPI2 config address read register

### 45.8.1 Control Register

Table 597. 0x00 - CTRL - Control register

	31	24	23	13	12	8	7	6	5	4	3	2	1	0
Key	R				WLEN	IAMBA	CPHA	CPOL	REV	R	RESET	ENR	ENN	
0	0				0x0F	0	0	0	1	0	0	1	1	
w	r				rw	rw	rw	rw	rw	r	rw	rw	rw	

- 31 Safety code (KEY) - Must be 0x68 when writing, otherwise register write is ignored
- 23 : 13 RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 12 : 8 Word length (WLEN) - The value of this field determines the length in bits of a transfer on the SPI bus. Valid values are 0x03 to 0x1F  
Word length is WLEN+1, allows words of length 4-32 bits.
- 7 AMBA Interrupt enable (IAMBA) - If set, AMBA interrupt generation is enabled for the events that are individually maskable by the Interrupt enable (INTE) register
- 6 Clock phase (CPHA) - When CPHA is '0' data will be read on the first transition of SCK. When CPHA is '1' data will be read on the second transition of SCK.
- 5 Clock polarity (CPOL) - Determines the polarity (idle state) of the SCK clock.
- 4 Reverse data (REV) - When this bit is '0' data is transmitted LSB first, when this bit is '1' data is transmitted MSB first.
- 3 RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 2 Reset (RESET) - Resets all the registers in the core except time registers (TIME1, TIME2) and core enable registers (ENN and ENR).
- 1 Enable redundant port transfer (ENR) - Enable bit for redundant port transfer.
- 0 Enable nominal port transfer (ENN) - Enable bit for nominal port transfer.

# LEON3FT Microcontroller

## 45.8.2 Status Register

Table 598.0x04 - STAT - Status register

31		8	7	6	5	4	3	2	1	0
	RESERVED		ATR	ATN	SAR	SIC	R	RR	RN	
	0		0	1	0	0	0	0	0	0
	r		r	r	r	r	r	r	r	r

- 31 : 3      RESERVED
- 7          Active transmission in redundant port (ATR) - This bit provides the status of the redundant transmission port. Set based on the incoming activate and deactivate commands (active '1' else '0'). Valid only for SPI protocol 2 implementation.
- 6          Active transmission in nominal port (ATN) - This bit provides the status of the nominal transmission port. Set based on the incoming activate and deactivate commands (active '1' else '0'). Valid only for SPI protocol 2 implementation.
- 5          Status address error (SAR) - This bit gets set to '1' when an AMBA write or read access resulted in an error. A valid new command clears this status bit. Valid only for SPI protocol 2 implementation.
- 4          Status illegal command (SIC) - This bit gets set to '1' when an illegal command is received. A valid new command clears this status bit. Valid only for SPI protocol 2 implementation.
- 3 : 2      RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 1          Received data redundant (RR) - This bit gets set to '1' each time a data is received in the redundant port. The bit gets set to '0' when the Redundant receive register is read.
- 0          Received data nominal (RN) - This bit gets set to '1' each time a data is received in the nominal port. The bit gets set to '0' when the Nominal receive register is read.

## 45.8.3 Transmit Register

Table 599.0x08 - TDATA - Transmit register

31		0
	TDATA	
	0	
	rw	

- 31 : 0      Transmit data (TDATA) - The written data is transferred to the master device when appropriate conditions for CS and SCK are satisfied. The word to transmit should be written with its least significant bit at bit 0. Also note that only the number of bits need to be transferred from this register should match the word length register (WLEN). Valid only for SPI protocol 0 and 1.

## 45.8.4 Nominal Receive Register

Table 600.0x0C - NRDATA - Nominal receive register

31		0
	NRDATA	
	0	
	r	

- 31 : 0      Nominal Receive data (NRDATA) - This register contains received data from the nominal port. Valid only for SPI protocol 0 and 1.

## 45.8.5 Redundant Receive Register

Table 601.0x10 - RRDATA - Redundant receive register

31		0
	RRDATA	
	0	

# LEON3FT Microcontroller

Table 601.0x10 - RRDATA - Redundant receive register

r
---

31 : 0 Redundant Receive data (RRDATA) - This register contains received data from the redundant port. Valid only for SPI protocol 0 and 1.

## 45.8.6 Interrupt Enable Register

Table 602.0x14 - INTE- Interrupt enable register

31	24	23	8	7	6	5	4	3	2	1	0
Key	RESERVED		WDE	AE	CRE	CWE	TICKE	SYNCE	RXRE	RXNE	
0	0		0	0	0	0	0	0	0	0	
w	r		rw	rw	rw	rw	rw	rw	rw	rw	

31 : 24 Safety code (KEY) - Must be 0x68 when writing, otherwise register write is ignored.  
 23 : 8 RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.  
 7 Write data interrupt enable (WDE). Valid only for SPI protocol 2.  
 6 AMBA access error interrupt enable (AE). Valid only for SPI protocol 2.  
 5 Change in config read address interrupt enable (CRE). Valid only for SPI protocol 2.  
 4 Change in config write address interrupt enable (CWE). Valid only for SPI protocol 2.  
 3 Tick command received interrupt enable (TICKE). Valid only for SPI protocol 2.  
 2 Sync command received interrupt enable (SYNCE). Valid only for SPI protocol 2.  
 1 Data received in redundant port interrupt enable (RXRE). Valid only for SPI protocol 0 and 1.  
 0 Data received in nominal port interrupt enable (RXNE). Valid only for SPI protocol 0 and 1.

# LEON3FT Microcontroller

## 45.8.7 Interrupt Register

Table 603.0x18- INT- Interrupt register

31	24	23	8	7	6	5	4	3	2	1	0
Key	RESERVED		WD	AI	CR	CW	TICK	SYNC	RXR	RXN	
0	0		0	0	0	0	0	0	0	0	0
w	r		wc	wc	wc	wc	wc	wc	wc	wc	wc

- 31 : 24 Safety code (KEY) - Must be 0x68 when writing, otherwise register write is ignored.
- 23 : 8 RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 7 Write data interrupt (WD). Valid only for SPI protocol 2.
- 6 AMBA access error interrupt (AI). Valid only for SPI protocol 2.
- 5 Change in config read address interrupt (CR). Valid only for SPI protocol 2.
- 4 Change in config write address interrupt (CW). Valid only for SPI protocol 2.
- 3 Tick command received interrupt (TICK). Valid only for SPI protocol 2.
- 2 Sync command received interrupt (SYNC). Valid only for SPI protocol 2.
- 1 Data received in redundant port interrupt (RXR). Valid only for SPI protocol 0 and 1.
- 0 Data received in nominal port interrupt (RXN). Valid only for SPI protocol 0 and 1.

## 45.8.8 SPI2 Control Register

Table 604.0x20- SPI2C- SPI2 control register

31	24	23	8	7	6	5	4	3	2	1	0
Key	RESERVED		MODSTAT				RESERVED		STF	EN	
0	0		0	0	0	0	0	0	0	0	1
w	r		rw	rw	rw	rw	r	r	rw	rw	

- 31 : 24 Safety code (KEY) - Must be 0x68 when writing, otherwise register write is ignored.
- 23 : 8 RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 7: 4 Module state (MODSTAT). The values in these bits are sent to the master via the response token. These are user configurable registers which can be set to '1' or '0'. Valid only for SPI protocol 2.
- 3: 2 RESERVED (R) - Read as zero and should be written to zero to ensure forward compatibility.
- 1 SPI terminal failure (STF). This value in this bit is sent to the master via the response token. In order to intimate a terminal failure this bit can be written to '1' through software. Valid only for SPI protocol 2.
- 0 Enable (EN). SPI protocol 2 enable bit. If set to '1' the commands received from master are handled by the SPI 2 protocol handler in the core. If set to '0' the data received and transfered are using the APB registers.

## 45.8.9 SPI2 Time1 Register

Table 605.0x24 - TIME1 - SPI2 time1 register

31	0
TIME1	
0x00000000	
r	

- 31 : 0 Time 1 register (TIME1) - Provides the most significant 32 bits of the time register. This is a status (read only) register, the contents of this register is a reflection of the time modified/incremented using the sync and tick command respectively.



# LEON3FT Microcontroller

## 45.8.10 SPI2 Time2 Register

Table 606.0x28 - TIME2 - SPI2 time2 register

31	0
TIME2	
0x00000000	
r	

31 : 0 Time 2 register (TIME2) - Provides the lower 32 bits of the time register. This is a status (read only) register, the contents of this register is a reflection of the time modified/incremented using the sync and tick command respectively.

## 45.8.11 SPI2 Config Address Write Register

Table 607.0x2C - CONFW - SPI2 config address write register

31	0
CONFW	
0x40000000	
r	

31 : 0 Configuration write address (CONFW) - Defines the base address for the memory area where the core is allowed to make accesses. This is a status (read only) register, the contents of this register can be modified by the configuration write address command.

## 45.8.12 SPI2 Config Address Read Register

Table 608.0x30 - CONFR - SPI2 config address read register

31	0
CONFR	
0x40000000	
r	

31 : 0 Configuration read address (CONFR) - Defines the base address for the memory area where the core is allowed to make accesses. This is a status (read only) register, the contents of this register can be modified by the configuration read address command.

# LEON3FT Microcontroller

## 46 SPI Memory Controller

The GR716 microcontroller comprises 2 separate SPI memory controller units (SPIMCTRLx). Each SPI memory controller unit controls its own external pins and has a unique AMBA address described in chapter 2.10. SPI memory controller unit 0 (SPIMCTRL0) has dedicated external signals, while SPI memory controller unit 1 (SPIMCTRL1) has access to external signals via IO switch matrix described in section 2.5.

Each SPI memory controller unit control and status register are located on main AHB bus in the address range from 0xFFFF0000 to 0xFFFF02FFF. See SPIMCTRL units connections in the next drawing. The figure shows memory locations and functions used for SPIMCTRL configuration and control.

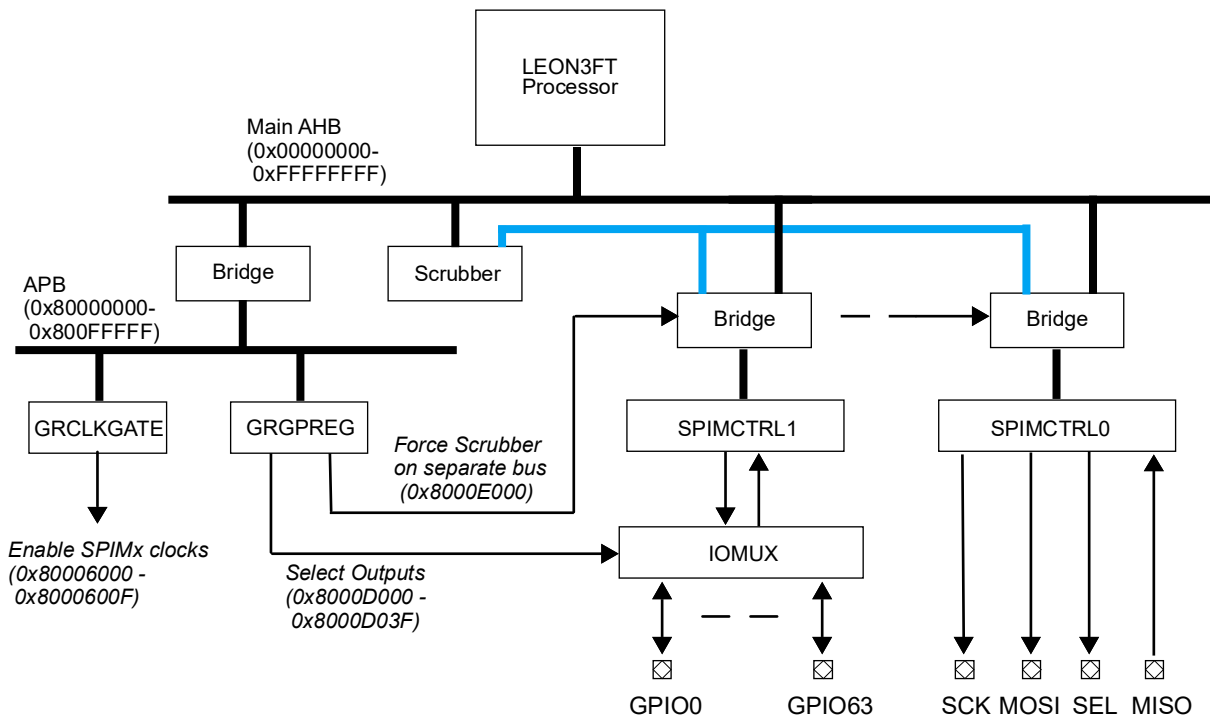


Figure 90. GR716 SPIMx bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable individual SPI memory controller units (SPIMCTRLx). The unit **GRCLKGATE** can also be used to perform reset of individual SPI memory controller units (SPIMCTRLx). Software must enable clock and release reset described in section 27 before SPI memory controller units (SPIMCTRLx) configuration and transfers can start.

External IO selection for SPI memory controller unit 1 (SPIMCTRL1) is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1 for further information.

Each **SPIMCTRLx** unit controls its own external pins and has a unique AMBA address described in chapter 2.10. SPIMCTRL unit 0 and 1 has identical configuration and status registers. Configuration and status registers are described in this section 46.3

System can be configured to scrub memory contents of individual SPIMCTRL units in the **SCRUBBER** unit. See section 42 for more information.

# LEON3FT Microcontroller

## 46.1 Overview

The core maps a memory device connected via the Serial Peripheral Interface (SPI) into AMBA address space. Read accesses are performed by performing normal AMBA read operations in the mapped memory area. Other operations, such as writes, are performed by directly sending SPI commands to the memory device via the core's register interface. The core is highly configurable and supports most SPI Flash memory devices.

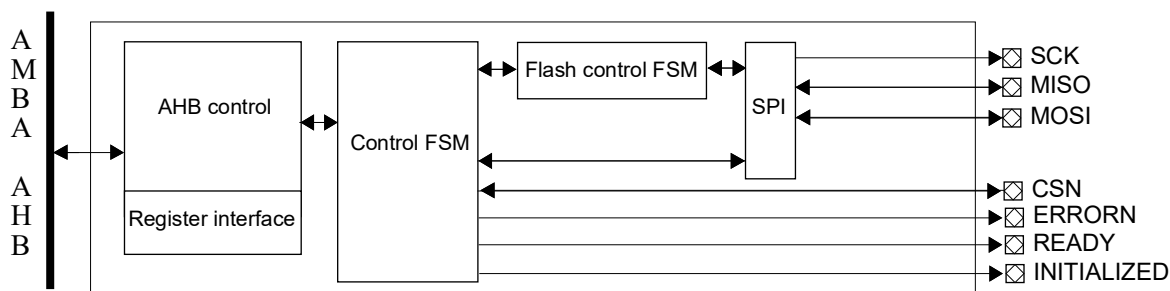


Figure 91. Block diagram

## 46.2 Operation

### 46.2.1 Operational model

The core has two memory areas that can be accessed via the AMBA bus; the I/O area and the ROM area. The ROM area maps the memory device into AMBA address space and the I/O area is utilized for status reporting and to issue user commands to the memory device.

When transmitting SPI commands directly to the device the ROM area should be left untouched. The core will issue an AMBA ERROR response if the ROM area is accessed when the core is busy performing an operation initiated via I/O registers.

Depending on the type of device attached the core may need to perform an initialization sequence. Accesses to the ROM area during the initialization sequence receive AMBA error responses. The core has successfully performed all necessary initialization when the Initialized bit in the core's status register is set.

### 46.2.2 I/O area

The I/O area contains registers that are used when issuing commands directly to the memory device. By default, the core operates in System mode where it will perform read operations on the memory device when the core's ROM area is accessed. Before attempting to issue commands directly to the memory device, the core must be put into User mode. This is done by setting the User Control (USRC) bit in the core's Control register. Care should be taken to not enter User mode while the core is busy, as indicated by the bits in the Status register. The core should also have performed a successful initialization sequence before User mode accesses (INIT bit in the Status register should be set).

Note that a memory device may need to be clocked when there has been a change in the state of the chip select signal. It is recommended that software transmits a byte with the memory device deselected after entering and before leaving User mode.

The following steps are performed to issue a command to the memory device after the core has been put into User mode:

1. Check Status register and verify that the BUSY and DONE bits are cleared. Also verify that the core is initialized and not in error mode.
2. Optionally enable DONE interrupt by setting the Control register bit IEN.
3. Write command to Transmit register.

# LEON3FT Microcontroller

4. Wait for interrupt (if enabled) or poll DONE bit in Status register.
5. When the DONE bit is set the core has transferred the command and will have new data available in the Receive register.
6. Clear the Status register's DONE bit by writing one to its position.

The core should not be brought out of User mode until the transfer completes. Accesses to ROM address space will receive an AMBA ERROR response when the core is in User mode and when an operation initiated under User mode is active.

### 46.2.3 ROM area

The ROM area only supports AMBA read operations. Write or locked access operations will receive AMBA ERROR responses. When a read access is made to the ROM area the core will perform a read operation on the memory device. The system has support for AMBA SPLIT responses and the core will issue command SPLIT the master until the read operation on the memory device has finished.

The AMBA read operation is transferred onto the external SPI interface using the parameters set in the configuration register. The read command bit field determines if normal or fast read is used. The additional bit fields determine the length of address and dummy state. The length of address and dummy bit fields are defined number of bytes.

Next is an example of using normal read. To enable normal read user should use the read command 0x3 and set number of dummy bytes to 0x0.

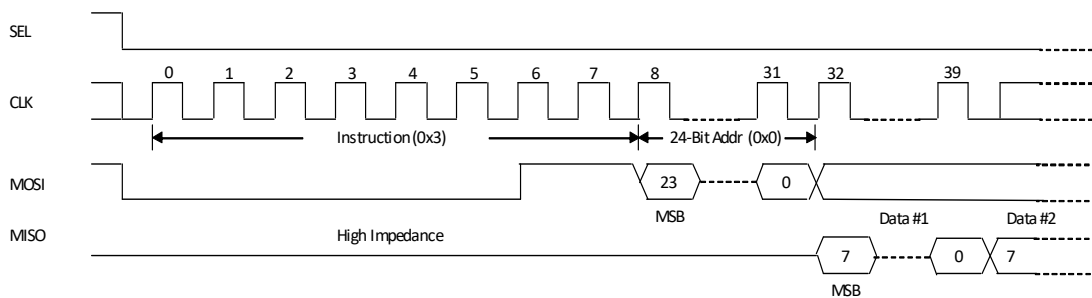


Figure 92. Read Data Bytes (READ) Instruction sequence and Data-Out sequence

Next is an example of using fast read. To enable normal read user should use the read command 0xB and set number of dummy bytes to 0x0 or greater. Note that the dummy byte bit field is set to 0x1 in the example but is set to 0x0 as default. The reason for this is that external SPI PROM might require additional dummy states at 50 MHz to return correct data.

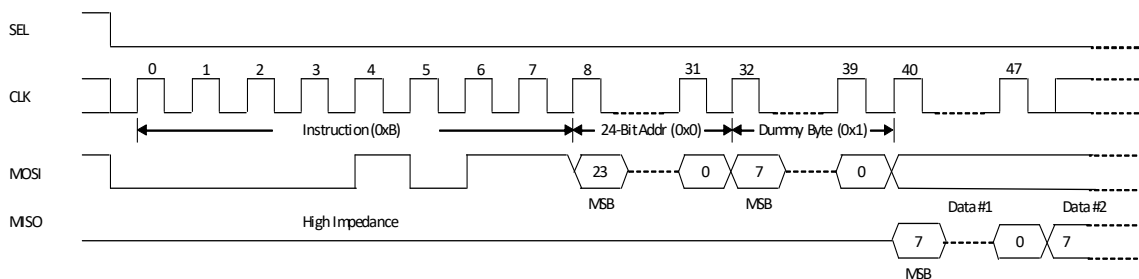


Figure 93. Read Data Bytes at higher speed (FAST\_READ) Instruction sequence and Data-Out sequence

The expected read performance is determined by the following factors:

- Scaler mode (CTRL.EAS)

# LEON3FT Microcontroller

- Number of address bytes used (CONF.ADDRBYTES)
- Fast or normal read mode i.e. number of dummy bytes required (CONF.DUMMYBYTES)
- Number of Data bytes read (AMBA transaction length. Valid length 1,2 or 4 bytes)
- EDAC Enabled (ECONF.EE)
- Internal system delay (approximately 3 SPI clock cycles)

The number of system clocks required for a SPI READ operation can be estimated using the formula:

$$SPIO_{P_{ClkCycles}} = (4 - CONF.ADDRBYTES + CONF.DUMMYBYTES + \langle NbrOfBytes \rangle) \times 8 \times (8 - 6 \times CTRL.EAS) \times (1 + ECONF.EE)$$

For an 32 bit instruction fetch using normal scaler this would result in approximately 540 system clocks.

BCH EDAC protection requires two consecutive reads from two non-consecutive address i.e. a SPI READ operation with EDAC enabled will require twice as many system clocks to be completed.

## 46.2.4 BCH EDAC

The SPIMCTRL is provided with an BCH EDAC that can correct one error and detect two errors in a 32-bit word. For each word, a 7-bit checksum is generated according to the equations below. A correctable error will be handled transparently by the memory controller, but adding one waitstate to the access. If an un-correctable error (double-error) is detected, the current AHB cycle will end with an error response. The EDAC can be used during access to SPI Memories areas by setting the EDAC enable bits in the EDAC configuration register. The equations below show how the EDAC checkbits are generated:

$$\begin{aligned} CB0 &= D0 \wedge D4 \wedge D6 \wedge D7 \wedge D8 \wedge D9 \wedge D11 \wedge D14 \wedge D17 \wedge D18 \wedge D19 \wedge D21 \wedge D26 \wedge D28 \wedge D29 \wedge D31 \\ CB1 &= D0 \wedge D1 \wedge D2 \wedge D4 \wedge D6 \wedge D8 \wedge D10 \wedge D12 \wedge D16 \wedge D17 \wedge D18 \wedge D20 \wedge D22 \wedge D24 \wedge D26 \wedge D28 \\ \overline{CB2} &= D0 \wedge D3 \wedge D4 \wedge D7 \wedge D9 \wedge D10 \wedge D13 \wedge D15 \wedge D16 \wedge D19 \wedge D20 \wedge D23 \wedge D25 \wedge D26 \wedge D29 \wedge D31 \\ \overline{CB3} &= D0 \wedge D1 \wedge D5 \wedge D6 \wedge D7 \wedge D11 \wedge D12 \wedge D13 \wedge D16 \wedge D17 \wedge D21 \wedge D22 \wedge D23 \wedge D27 \wedge D28 \wedge D29 \\ CB4 &= D2 \wedge D3 \wedge D4 \wedge D5 \wedge D6 \wedge D7 \wedge D14 \wedge D15 \wedge D18 \wedge D19 \wedge D20 \wedge D21 \wedge D22 \wedge D23 \wedge D30 \wedge D31 \\ CB5 &= D8 \wedge D9 \wedge D10 \wedge D11 \wedge D12 \wedge D13 \wedge D14 \wedge D15 \wedge D24 \wedge D25 \wedge D26 \wedge D27 \wedge D28 \wedge D29 \wedge D30 \wedge D31 \\ CB6 &= D0 \wedge D1 \wedge D2 \wedge D3 \wedge D4 \wedge D5 \wedge D6 \wedge D7 \wedge D24 \wedge D25 \wedge D26 \wedge D27 \wedge D28 \wedge D29 \wedge D30 \wedge D31 \end{aligned}$$

Data is always accessed as words (4 bytes at a time) and the corresponding checkbits are located at the address acquired by inverting the word address using it as a byte address. The chip-select is kept active. A word written as four bytes to addresses 0, 1, 2, 3 will have its checkbits at address 0xFFFFFFFF, addresses 4, 5, 6, 7 at 0xFFFFFFFFE and so on. All the bits up to the maximum bank size will be inverted while the same chip-select is always asserted. This way all the bank sizes can be supported and no memory will be unused (except for a maximum of 4 byte in the gap between the data and checkbit area). A read access will automatically read the four data bytes individually from the nominal addresses and the EDAC checkbit byte from the top part of the bank.

Write accesses are not being handled automatically. Instead, write accesses must only be performed as individual word accesses by the software, writing one word at a time, and the corresponding checkbit byte must be calculated and be written to the correct location by the software.

If a correctable EDAC error is detected during a memory read, the ERR bit in the EDAC Status Register is set and. If an uncorrectable EDAC error is detected during a read operation, the MERR bit in the EDAC Status Register will be set and an error response will be generated on the AHB access.

## 46.2.5 Extended Address mode operation

The SPIMCTRL can operate in 4 byte address mode when access at address area for 4 byte address access, see Table 18. Or when the SPIM CTRL interface is forced via the control bit CONF.F4B.

# LEON3FT Microcontroller

## 46.3 Registers

The core is programmed through registers mapped into AHB address space.

Table 609.SPIMCTRL registers

AHB address offset	Register
0x00	Configuration register
0x04	Control register
0x08	Status register
0x0C	Receive register
0x10	Transmit register
0x14	EDAC configuration register
0x18	EDAC status register

# LEON3FT Microcontroller

## 46.3.1 Configuration Register

Table 610.0x00 - CONF - Configuration register

31	24	23	16	15	14	13	12	11	10	9	8	7	0
AMASK		READCMD4		RESERVED			F4B	DUMMYBYTES		ADDRBYTES		READCMD	
0x0		0x13		0			0x0	0x0		0x0		0x3	
rw		rw		r			rw	rw		rw		rw	

- 31 :24 Address Mask Bits (AMASK) - Mask highest address bits
- 23 :16 Read instruction (READCMD4) - Read instruction that the core will use for reading from the memory device in 4byte address mode.
- 15 :12 RESERVED
- 12 Force 4 Byte Address Mode (F4B)
- 11:10 Use Dummy Byte (DUMMYBYTES) - Insert dummy bytes after last address bytes for higher speed rates i.e. when read instruction bit is set to use FAST read mode. The bit field DUMMYBYTES is the number of dummy bytes that is inserted after the last address byte.
- 9:8 Reduce number of address bytes (ADDRBYTES) - Default number of address bytes is set to 3.
  - "00" Use 3 address bytes (Default)
  - "01" Use 2 address bytes
  - "10" Use 1 address byte
  - "11" Use 3 address bytes. Bit field ADDRBYTES will automatically reset back to "00".
- 7:0 Read instruction (READCMD) - Read instruction that the core will use for reading from the memory device.

## 46.3.2 Control Register

Table 611.0x04 - CTRL - Control register

31	5	4	3	2	1	0		
RESERVED				RST	CSN	EAS	IEN	USRC
				0	1	0	0	0
				rw	rw	rw	rw	rw

- 31 :5 RESERVED
- 4 Reset core (RST) - By writing '1' to this bit the user can reset the core. This bit is automatically cleared when the core has been reset. Reset core should be used with care. Writing this bit has the same effect as system reset. Any ongoing transactions, both on AMBA and to the SPI device will be aborted.
- 3 Chip select (CSN) - Controls core chip select signal. This field always shows the level of the core's internal chip select signal. This bit is always automatically set to '1' when leaving User mode by writing USRC to '0'.
- 2 Enable Alternate Scaler (EAS) - When this bit is set the SPI clock is divided by using the alternate scaler. Set scaler to system clock frequency divided by 4. Default scaler is system clock divided by 16.
- 1 Interrupt Enable (IEN) - When this bit is set the core will generate an interrupt when a User mode transfer completes.
- 0 User control (USRC) - When this bit is set to '1' the core will accept SPI data via the transmit register. Accesses to the memory mapped device area will return AMBA ERROR responses.

## 46.3.3 Status Register

Table 612.0x08 - STAT - Status register

31	3	2	1	0	
RESERVED			INIT	BUSY	DONE
0			0	0	0
r			r	r	wc

# LEON3FT Microcontroller

Table 612.0x08 - STAT - Status register

31:3	RESERVED
2	Initialized (INIT) - This read only bit is set to '1' when the SPI memory device has been initialized. Accesses to the ROM area should only be performed when this bit is set to '1'.
1	Core busy (BUSY) - This bit is set to '1' when the core is performing an SPI operation.
0	Operation done (DONE) - This bit is set to '1' when the core has transferred an SPI command in user mode.

Reset value: 0x00000000

## 46.3.4 Receive Register

Table 613.0x0C - RX - Receive register

31	RESERVED	8	7	0
	0			RDATA
	R			nr
				rw

31 :8	RESERVED
7:0	Receive data (RDATA) : Contains received data byte

Reset value: 0x000000UU, where U is undefined

## 46.3.5 Transmit Register

Table 614.0x10 - TX - Transmit register

31	RESERVED	8	7	0
	0			TDATA
	r			0
				rw

31 :8	RESERVED
7:0	Transmit data (TDATA) - Data byte to transmit

## 46.3.6 EDAC Configuration Register

Table 615.0x14 - ECONF - EDAC Configuration register

31	RESERVED	1	0
	0		EE
	r		0x0
			rw

31 :1	RESERVED
0	Enable EDAC BCH Protection (EE) - Enables BCH protection and correction

## 46.3.7 EDAC Status Register

Table 616.0x18 - ESTAT - EDAC Status register

31	RESERVED	2	1	0
	0		MERR	ERR
	r		0x0	0x0
			rw	rw

31 :2	RESERVED
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# LEON3FT Microcontroller

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Table 616.0x18 - ESTAT - EDAC Status register

1	Data word with multiple bit errors has been detected
0	Correctable Errors has been detected

# LEON3FT Microcontroller

## 47 AMBA Protection Unit

The GR716 microcontroller comprises two separate AMBA memory protection units (MEMPROT). The MEMPROT units described in this section have the capability to detect and protect memory areas from write accesses.

The first AMBA memory protection units (MEMPROT0) is connected to Main AHB bus and the second AMBA memory protection units (MEMPROT1) is connected to the DMA AMBA bus. Each AMBA memory protection unit has a unique AMBA address described in chapter 2.10 for configuration and status.

The control and status registers for the AMBA memory protection units are located on the APB bus in the address range from 0x80005000 to 0x80005FFF and in the range from 0x8010A000 to 0x8010AFFF. See AMBA memory protection units connections in the next drawing. The figure shows memory locations and functions used for AMBA memory protection units configuration and control.

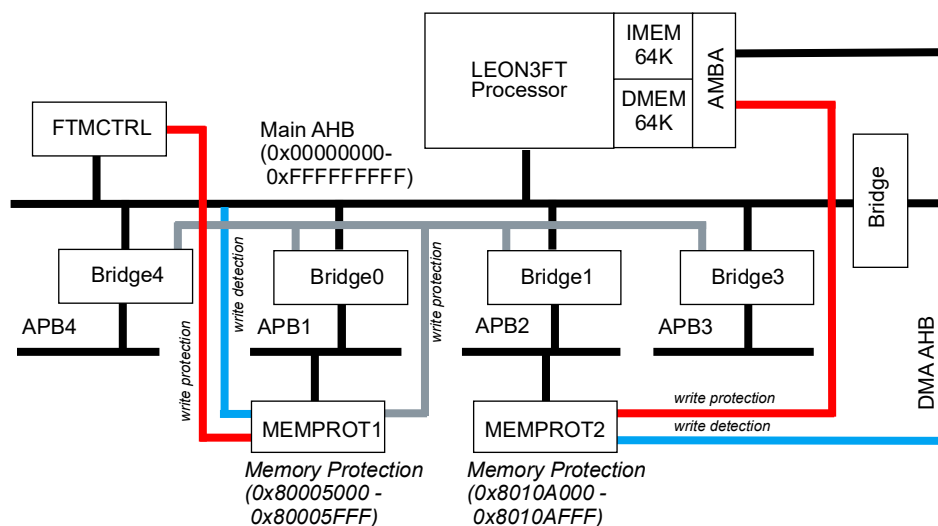


Figure 94. GR716 MEMPROTx bus connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the AMBA memory protection units. The unit **GRCLKGATE** can also be used to perform reset of individual AMBA memory protection units. Software must enable clock and release reset described in section 27 before configuration.

The system can be configured to protect and restrict access to the AMBA memory protection units.

### 47.1 Overview

The AMBA Protection unit allows user to define memory segments for protection, memory segments are defined by an start and stop address, to which write permissions can be set. The AMBA protection unit supports up to four individual segments for the system bus and four segments for the dma bus.

The memory protection unit can also restrict write access to individual APB slave interface for specific AHB masters. The restriction needs to be enabled by the user or software. It should be noted that write access to registers in the memory protection can not be restricted to prevent situation where the system can't control APB accesses.

The LEON3FT microcontroller includes 2 separate memory protection units hence register map is split into separate chapters for system and dma bus. The first protection unit monitors masters accesses on the system bus and the second protection unit monitors masters accesses on the DMA bus.

# LEON3FT Microcontroller

## 47.2 Operation

The External memory controller, On-chip memory controller and APB controller allows the software to define write protected memory segments, memory segments are defined by a start address and end address, to which write permissions for specific bus masters can be granted or denied. Four segments can be identified with a segment ID between 0 to 3. A segment with a low ID has precedence over one with a high ID, but only if the segment with lower ID is enabled. The precedence or segment ID are only of interests when specified memory area overlaps or bus masters are the same.

Each segment can be configured to grant or deny a write access individually for each AMBA master on the bus. This is done by setting the Enable bits in the relevant Configuration register for the segment.

The protection unit on the main bus provides also access control registers, to manage grants for each master to write in APB slaves on the main bus. They restricts write access to selected APB slaves for each master when the corresponding bit in the corresponding register is set high.

## 47.3 Registers

The core is programmed through registers mapped into APB address space.

Table 617. AHB system and DMA protection configuration and status registers

APB address offset	Registers
<i>Memory Protection Unit for system bus (0x80005000)</i>	
0x80005000	Protection Configuration register
0x80005004	Protection Segment 0 Start Address register
0x80005008	Protection Segment 0 End Address register
0x8000500C	Protection Segment 0 Configuration register
0x80005010	Not used
0x80005014	Protection Segment 1 Start Address register
0x80005018	Protection Segment 1 End Address register
0x8000501C	Protection Segment 1 Configuration register
0x80005020	Not used
0x80005024	Protection Segment 2 Start Address register
0x80005028	Protection Segment 2 End Address register
0x8000502C	Protection Segment 2 Configuration register
0x80005030	Not used
0x80005034	Protection Segment 3 Start Address register
0x80005038	Protection Segment 3 End Address register
0x8000503C	Protection Segment 3 Configuration register
0x80005040 - 0x800050FF	Not used
0x80005100	Access control for CPU and BRIDGE on APB bus 0
0x80005104	Access control for Scrubber on APB bus 0
0x80005108 - 0x8000510F	Not used
0x80005110	Access control for DMA controller #0 and # 1 on APB bus 0
0x80005114	Access control for DMA controller #2 and # 3 on APB bus 0
0x80005118 - 0x8000513F	Not used
0x80005140	Access control for CPU and BRIDGE on APB bus 1
0x80005144	Access control for Scrubber on APB bus 1
0x80005148 - 0x8000514F	Not used
0x80005150	Access control for DMA controller #0 and # 1 on APB bus 1

# LEON3FT Microcontroller

Table 617. AHB system and DMA protection configuration and status registers

APB address offset	Registers
0x80005154	Access control for DMA controller #2 and #3 on APB bus 1
0x80005158 - 0x8000517F	Not used
0x80005180	Access control for CPU and BRIDGE on APB bus 3
0x80005184	Access control for Scrubber on APB bus 3
0x80005188 - 0x8000518F	Not used
0x80005190	Access control for DMA controller #0 and #1 on APB bus 3
0x80005194	Access control for DMA controller #2 and #3 on APB bus 3
0x80005198 - 0x800051BF	Not used
0x800051C0	Access control for CPU and BRIDGE on APB bus 4
0x800051C4	Access control for Scrubber on APB bus 4.
0x800051C8 - 0x800051DF	Not used
0x800051E0	Access control for DMA controller #0 and #1 on APB bus 4
0x800051E4	Access control for DMA controller #2 and #3 on APB bus 4
0x800051E8 - 0x80005FFF	Not used
<i>Memory Protection Unit for DMA bus (0x8010A000)</i>	
0x8010A000	Protection Configuration register
0x8010A004	Protection Segment 0 Start Address register
0x8010A008	Protection Segment 0 End Address register
0x8010A00C	Protection Segment 0 Configuration register
0x8010A010	Not used
0x8010A014	Protection Segment 1 Start Address register
0x8010A018	Protection Segment 1 End Address register
0x8010A01C	Protection Segment 1 Configuration register
0x8010A020	Not used
0x8010A024	Protection Segment 2 Start Address register
0x8010A028	Protection Segment 2 End Address register
0x8010A02C	Protection Segment 2 Configuration register
0x8010A030	Not used
0x8010A034	Protection Segment 3 Start Address register
0x8010A038	Protection Segment 3 End Address register
0x8010A03C	Protection Segment 3 Configuration register
0x8010A040 - 0x8010AFFF	Not used

## 47.3.1 System Protection register description

This chapter specifies access control registers for peripherals and registers accessible 0x40000000 to 0x4FFFFFFF and the range 0x80000000 to 0x8041FFFF.

# LEON3FT Microcontroller

Table 618. 0x80005000 - PCR - Protection Configuration register

31	24 23	4 3	1 0
NSEG	Reserved	PROT	EN
0x4	0x0	0x0	0
r	r	rw	rw

- 31: 24 NSEG - Number of segments supported.
- 23: 4 Reserved
- 3: 1 PROT - Protection of memory control access. This bit field needs to be set to 101b in order to be able to change any register configuration of the memory protection.
- 0 EN - Enable Memory Protection of specified memory segments. This bit is used to enable and disable all protected segments at the same-time.

Table 619. 0x80005004 + segment\*0x10 - PSA - Protection Segment Start Address register

31	0
SADDR	
0x0	
rw	

- 31: 0 SADDR - Start address of segment. Start address should be in the range 0x40000000 to 0x4FFFFFFF and the range 0x80000000 to 0x8041FFFF.

Table 620. 0x80005008 + segment\*0x10 - PEA - Protection Segment End Address register

31	0
EADDR	
0x0	
rw	

- 31: 0 EADDR - End address of segment. End address should be in the range 0x40000000 to 0x4FFFFFFF and the range 0x80000000 to 0x8041FFFF.

Table 621. 0x8000500C + segment\*0x10 - PSC - Protection Segment Control register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	1	0											
Reserved													G2	G1	G0	Reserved													EN
0													0	0	0	0													0
r													rw	rw	rw	r													rw

- 31: 19 RESERVED
- 18 G2 - Grant SCRUBBER on the main bus exclusive write permission
- 17 G1 - Grant DMA bus masters exclusive write permission. DMA bus masters can be any master performing accesses on the DMA bus i.e. SpaceWire, CAN, MIL-1553, UART, I2C, PacketWire and/or DMA
- 16 G0 - Grant LEON3FT processor exclusive write permission
- 15: 1 RESERVED
- 0 EN - Enable Memory Protection for specified memory segments. This bit will grant exclusive write permission to specified masters within protected memory segment

# LEON3FT Microcontroller

## 47.3.2 Protection register for AMBA APB 0

This chapter specifies access control registers for peripherals and registers accessible 0x80000000 to 0x8000FFFF.

Table 622. 0x80005100 - APB0PROT0 - APB Control 0 Protection register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
C15	C14	C13	C12	C11	C10	C9	C8	C7	C6	C5	C4	C3	C2	C1	C0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

- 31 Memory controller with EDAC (C15)
- 30 Multi-processor Interrupt Ctrl. (C14)
- 29 C Modular Timer Unit 0 (C13)
- 28 P Modular Timer Unit 1 (C12)
- 27 U Memory Protection Unit for system bus (C11)
- 26 Clock gating configuration register unit 0 (C10)
- 25 C Clock gating configuration register unit 1 (C9)
- 23 O Configuration and test registers (C8)
- 24 N LEON3 Statistics Unit (C7)
- 22 T AHB Status Register (C6)
- 21 R On-chip Instruction memory control registers (C5)
- 20 O CCSDS TDP / SpaceWire I/F (C4)
- 19 L IO Mux configuration register (C3)
- 18 CCSDS TDP / SpaceWire I/F (C2)
- 17 Test register used for test purpose (C1)
- 16 Slave UART configuration (C0)
- 15 Memory controller with EDAC (B15)
- 14 B Multi-processor Interrupt Ctrl. (B14)
- 13 R Modular Timer Unit 0 (B13)
- 12 I Modular Timer Unit 1 (B12)
- 11 D Memory Protection Unit for system bus (B11)
- 10 G Clock gating configuration register unit 0 (B10)
- 9 E Clock gating configuration register unit 1 (B9)
- 8 Configuration and test registers (B8)
- 7 C LEON3 Statistics Unit (B7)
- 6 O AHB Status Register (B6)
- 5 N On-chip Instruction memory control registers (B5)
- 4 T CCSDS TDP / SpaceWire I/F (B4)
- 3 R IO Mux configuration register (B3)
- 2 L CCSDS TDP / SpaceWire I/F (B2)
- 1 Test register used for test purpose (B1)
- 0 Slave UART configuration (B0)

Table 623. 0x0x80005104 - APB0PROT1 - APB Control 0 Protection register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED																B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0																0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r																rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

# LEON3FT Microcontroller

Table 623. 0x0x80005104 - APB0PROT1 - APB Control 0 Protection register 1

31: 16	Not Used
15	Memory controller with EDAC (B15)
14	Multi-processor Interrupt Ctrl. (B14)
13	S Modular Timer Unit 0 (B13)
12	C Modular Timer Unit 1 (B12)
11	R Memory Protection Unit for system bus (B11)
10	U Clock gating configuration register unit 0 (B10)
9	B Clock gating configuration register unit 1 (B9)
8	Configuration and test registers (B8)
7	C LEON3 Statistics Unit (B7)
6	O AHB Status Register (B6)
5	N On-chip Instruction memory control registers (B5)
4	T CCSDS TDP / SpaceWire I/F (B4)
3	R IO Mux configuration register (B3)
2	L CCSDS TDP / SpaceWire I/F (B2)
1	Test register used for test purpose (B1)
0	Slave UART configuration (B0)

Table 624. 0x0x80005110 - APB0PROT2 - APB Control 0 Protection register 2

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

31	Memory controller with EDAC (A15)
30	D Multi-processor Interrupt Ctrl. (A14)
29	M Modular Timer Unit 0 (A13)
28	A Modular Timer Unit 1 (A12)
27	0 Memory Protection Unit for system bus (A11)
26	Clock gating configuration register unit 0 (A10)
25	C Clock gating configuration register unit 1 (A9)
23	O Configuration and test registers (A8)
24	N LEON3 Statistics Unit (A7)
22	T AHB Status Register (A6)
21	R On-chip Instruction memory control registers (A5)
20	O CCSDS TDP / SpaceWire I/F (A4)
19	L IO Mux configuration register (A3)
18	CCSDS TDP / SpaceWire I/F (A2)
17	Test register used for test purpose (A1)
16	Slave UART configuration (A0)
15	Memory controller with EDAC (B15)
14	D Multi-processor Interrupt Ctrl. (B14)
13	M Modular Timer Unit 0 (B13)
12	A Modular Timer Unit 1 (B12)
11	I Memory Protection Unit for system bus (B11)
10	Clock gating configuration register unit 0 (B10)
9	C Clock gating configuration register unit 1 (B9)
8	O Configuration and test registers (B8)

# LEON3FT Microcontroller

Table 624. 0x0x80005110 - APB0PROT2 - APB Control 0 Protection register 2

7	N	LEON3 Statistics Unit (B7)
6	T	AHB Status Register (B6)
5	R	On-chip Instruction memory control registers (B5)
4	O	CCSDS TDP / SpaceWire I/F (B4)
3	L	IO Mux configuration register (B3)
2		CCSDS TDP / SpaceWire I/F (B2)
1		Test register used for test purpose (B1)
0		Slave UART configuration (B0)

Table 625. 0x0x80005114 - APB0PROT3 - APB Control 0 Protection register 3

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

31		Memory controller with EDAC (A15)
30	D	Multi-processor Interrupt Ctrl. (A14)
29	M	Modular Timer Unit 0 (A13)
28	A	Modular Timer Unit 1 (A12)
27	2	Memory Protection Unit for system bus (A11)
26		Clock gating configuration register unit 0 (A10)
25	C	Clock gating configuration register unit 1 (A9)
23	O	Configuration and test registers (A8)
24	N	LEON3 Statistics Unit (A7)
22	T	AHB Status Register (A6)
21	R	On-chip Instruction memory control registers (A5)
20	O	CCSDS TDP / SpaceWire I/F (A4)
19	L	IO Mux configuration register (A3)
18		CCSDS TDP / SpaceWire I/F (A2)
17		Test register used for test purpose (A1)
16		Slave UART configuration (A0)
15		Memory controller with EDAC (B15)
14	D	Multi-processor Interrupt Ctrl. (B14)
13	M	Modular Timer Unit 0 (B13)
12	A	Modular Timer Unit 1 (B12)
11	3	Memory Protection Unit for system bus (B11)
10		Clock gating configuration register unit 0 (B10)
9	C	Clock gating configuration register unit 1 (B9)
8	O	Configuration and test registers (B8)
7	N	LEON3 Statistics Unit (B7)
6	T	AHB Status Register (B6)
5	R	On-chip Instruction memory control registers (B5)
4	O	CCSDS TDP / SpaceWire I/F (B4)
3	L	IO Mux configuration register (B3)
2		CCSDS TDP / SpaceWire I/F (B2)
1		Test register used for test purpose (B1)
0		Slave UART configuration (B0)



# LEON3FT Microcontroller

## 47.3.3 Protection register for AMBA APB 1

This chapter specifies access control registers for peripherals and registers accessible 0x80100000 to 0x8010FFFF.

Table 626. 0x0x80005140 - APB1PROT0 - APB Control 1 Protection register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
C15	C14	C13	C12	C11	C10	C9	C8	C7	C6	C5	C4	C3	C2	C1	C0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

- 31 GRSPW2 SpaceWire Serial Link (C15)
- 30 MIL-STD-1553B Interface. (C14)
- 29 C CAN Controller with DMA (C13)
- 28 P CAN Controller with DMA (C12)
- 27 U SPI to AHB Bridge (C11)
- 26 I2C to AHB Bridge (C10)
- 25 C Stand alone DMA unit 0 (C9)
- 23 O Stand alone DMA unit 1 (C8)
- 24 N Stand alone DMA unit 2 (C7)
- 22 T Stand alone DMA unit 3 (C6)
- 21 R On-chip Instruction memory control registers (C5)
- 20 O Memory protection for DMA bus (C4)
- 19 L IO Mux configuration register (C3)
- 18 PLL control registers (C2)
- 17 PacketWire Receiver with DMA (C1)
- 16 PacketWire Transmitter with DMA (C0)
- 15 GRSPW2 SpaceWire Serial Link (B15)
- 14 B MIL-STD-1553B Interface (B14)
- 13 R CAN Controller with DMA (B13)
- 12 I CAN Controller with DMA (B12)
- 11 D SPI to AHB Bridge (B11)
- 10 G I2C to AHB Bridge (B10)
- 9 E Stand alone DMA unit 0 (B9)
- 8 Stand alone DMA unit 1 (B8)
- 7 C Stand alone DMA unit 2 (B7)
- 6 O Stand alone DMA unit 3 (B6)
- 5 N Memory protection for DMA bus (B5)
- 4 T CCSDS TDP / SpaceWire I/F (B4)
- 3 R Brown-Out detection control registers (B3)
- 2 L PLL control registers (B2)
- 1 PacketWire Receiver with DMA (B1)
- 0 PacketWire Transmitter with DMA (B0)

Table 627. 0x0x80005144 - APB1PROT1 - APB Control 1 Protection register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED																B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0																0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r																rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

# LEON3FT Microcontroller

Table 627. 0x0x80005144 - APB1PROT1 - APB Control 1 Protection register 1

31: 16	Not Used
15	GRSPW2 SpaceWire Serial Link (B15)
14	MIL-STD-1553B Interface (B14)
13	S CAN Controller with DMA (B13)
12	C CAN Controller with DMA (B12)
11	R SPI to AHB Bridge (B11)
10	U I2C to AHB Bridge (B10)
9	B Stand alone DMA unit 0 (B9)
8	Stand alone DMA unit 1 (B8)
7	C Stand alone DMA unit 2 (B7)
6	O Stand alone DMA unit 3 (B6)
5	N Memory protection for DMA bus (B5)
4	T CCSDS TDP / SpaceWire I/F (B4)
3	R Brown-Out detection control registers (B3)
2	L PLL control registers (B2)
1	PacketWire Receiver with DMA (B1)
0	PacketWire Transmitter with DMA (B0)

Table 628. 0x0x80005150 - APB1PROT2 - APB Control 1 Protection register 2

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

31	GRSPW2 SpaceWire Serial Link (C15)
30	D MIL-STD-1553B Interface. (C14)
29	M CAN Controller with DMA (C13)
28	A CAN Controller with DMA (C12)
27	0 SPI to AHB Bridge (C11)
26	I2C to AHB Bridge (C10)
25	C Stand alone DMA unit 0 (C9)
23	O Stand alone DMA unit 1 (C8)
24	N Stand alone DMA unit 2 (C7)
22	T Stand alone DMA unit 3 (C6)
21	R On-chip Instruction memory control registers (C5)
20	O Memory protection for DMA bus (C4)
19	L IO Mux configuration register (C3)
18	PLL control registers (C2)
17	PacketWire Receiver with DMA (C1)
16	PacketWire Transmitter with DMA (C0)
15	GRSPW2 SpaceWire Serial Link (B15)
14	D MIL-STD-1553B Interface (B14)
13	M CAN Controller with DMA (B13)
12	A CAN Controller with DMA (B12)
11	I SPI to AHB Bridge (B11)
10	I2C to AHB Bridge (B10)
9	C Stand alone DMA unit 0 (B9)
8	O Stand alone DMA unit 1 (B8)

# LEON3FT Microcontroller

Table 628. 0x0x80005150 - APB1PROT2 - APB Control 1 Protection register 2

7	N	Stand alone DMA unit 2 (B7)
6	T	Stand alone DMA unit 3 (B6)
5	R	Memory protection for DMA bus (B5)
4	O	CCSDS TDP / SpaceWire I/F (B4)
3	L	Brown-Out detection control registers (B3)
2		PLL control registers (B2)
1		PacketWire Receiver with DMA (B1)
0		PacketWire Transmitter with DMA (B0)

Table 629. 0x0x80005154 - APB1PROT3 - APB Control 1 Protection register 3

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

31		GRSPW2 SpaceWire Serial Link (C15)
30	D	MIL-STD-1553B Interface. (C14)
29	M	CAN Controller with DMA (C13)
28	A	CAN Controller with DMA (C12)
27	2	SPI to AHB Bridge (C11)
26		I2C to AHB Bridge (C10)
25	C	Stand alone DMA unit 0 (C9)
23	O	Stand alone DMA unit 1 (C8)
24	N	Stand alone DMA unit 2 (C7)
22	T	Stand alone DMA unit 3 (C6)
21	R	On-chip Instruction memory control registers (C5)
20	O	Memory protection for DMA bus (C4)
19	L	IO Mux configuration register (C3)
18		PLL control registers (C2)
17		PacketWire Receiver with DMA (C1)
16		PacketWire Transmitter with DMA (C0)
15		GRSPW2 SpaceWire Serial Link (B15)
14	D	MIL-STD-1553B Interface (B14)
13	M	CAN Controller with DMA (B13)
12	A	CAN Controller with DMA (B12)
11	3	SPI to AHB Bridge (B11)
10		I2C to AHB Bridge (B10)
9	C	Stand alone DMA unit 0 (B9)
8	O	Stand alone DMA unit 1 (B8)
7	N	Stand alone DMA unit 2 (B7)
6	T	Stand alone DMA unit 3 (B6)
5	R	Memory protection for DMA bus (B5)
4	O	CCSDS TDP / SpaceWire I/F (B4)
3	L	Brown-Out detection control registers (B3)
2		PLL control registers (B2)
1		PacketWire Receiver with DMA (B1)
0		PacketWire Transmitter with DMA (B0)

# LEON3FT Microcontroller

## 47.3.4 Protection register for AMBA APB 3

This subsection specifies access control registers for peripherals and registers accessible 0x80000 to 0x8030FFFF.

Table 630. 0x0x80005180 - APB3PROT0 - APB Control 3 Protection register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
C15	C14	C13	C12	C11	C10	R	R	C7	C6	C5	C4	C3	C2	C1	C0	B15	B14	B13	B12	B11	B10	R	R	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	r	r	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	r	r	rW	rW	rW	rW	rW	rW	rW	rW

- 31           Generic UART 0 (C15)
- 30           Generic UART 1 (C14)
- 29    C     Generic UART 2 (C13)
- 28    P     Generic UART 3(C12)
- 27    U     Generic UART 4 (C11)
- 26           Generic UART 5 (C10)
- 25    C     unused
- 24    O     unused
- 23    N     External ADC / DAC Interface (C7)
- 22    T     SPI Controller 0 (C6)
- 21    R     SPI Controller 1 (C5)
- 20    O     PWM generator (C4)
- 19    L     General Purpose I/O port 0 to 31(C3)
- 18           General Purpose I/O port 32 to 64 (C2)
- 17           I2C-master 0 (C1)
- 16           I2C-master 1 (C0)
- 15           Generic UART 0 (B15)
- 14    B     Generic UART 1 (B14)
- 13    R     Generic UART 2 (B13)
- 12    I     Generic UART 3(B12)
- 11    D     Generic UART 4 (B11)
- 10    G     Generic UART 5 (B10)
- 9     E     unused
- 8           unused
- 7     C     External ADC / DAC Interface (B7)
- 6     O     SPI Controller 0 (B6)
- 5     N     SPI Controller 1 (B5)
- 4     T     PWM generator (B4)
- 3     R     General Purpose I/O port 0 to 31(B3)
- 2     L     General Purpose I/O port 32 to 64 (B2)
- 1           I2C-master 0 (B1)
- 0           I2C-master 1 (B0)

Table 631. 0x0x80005184 - APB3PROT1 - APB Control 3 Protection register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED																B15	B14	B13	B12	B11	B10	R	R	B7	B6	B5	B4	B3	B2	B1	B0
0x0																0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r																rW	rW	rW	rW	rW	rW	r	r	rW	rW	rW	rW	rW	rW	rW	rW

# LEON3FT Microcontroller

Table 631. 0x0x80005184 - APB3PROT1 - APB Control 3 Protection register 1

31: 16		Not Used
15		Generic UART 0 (B15)
14		Generic UART 1 (B14)
13	S	Generic UART 2 (B13)
12	C	Generic UART 3(B12)
11	R	Generic UART 4 (B11)
10	U	Generic UART 5 (B10)
9	B	unused
8		unused
7	C	External ADC / DAC Interface (B7)
6	O	SPI Controller 0 (B6)
5	N	SPI Controller 1 (B5)
4	T	PWM generator (B4)
3	R	General Purpose I/O port 0 to 31(B3)
2	L	General Purpose I/O port 32 to 64 (B2)
1		I2C-master 0 (B1)
0		I2C-master 1 (B0)

Table 632. 0x0x80005190 - APB3PROT2 - APB Control 3 Protection register 2

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	R	R	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	R	R	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rw	rw	rw	rw	rw	rw	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r	r	rw	rw	rw	rw	rw	rw	rw	rw

31		Generic UART 0 (A15)
30	D	Generic UART 1 (A14)
29	M	Generic UART 2 (A13)
28	A	Generic UART 3 (A12)
27	0	Generic UART 4 (A11)
26		Generic UART 5 (A10)
25	C	unused
23	O	unused
24	N	External ADC / DAC Interface (A7)
22	T	SPI Controller 0 (A6)
21	R	SPI Controller 1 (A5)
20	O	PWM generator (A4)
19	L	General Purpose I/O port 0 to 31 (A3)
18		General Purpose I/O port 32 to 64 (A2)
17		I2C-master 0 (A1)
16		I2C-master 1 (A0)
15		Generic UART 0 (B15)
14	D	Generic UART 1 (B14)
13	M	Generic UART 2 (B13)
12	A	Generic UART 3(B12)
11	I	Generic UART 4 (B11)
10		Generic UART 5 (B10)
9	C	unused
8	O	unused

# LEON3FT Microcontroller

Table 632. 0x0x80005190 - APB3PROT2 - APB Control 3 Protection register 2

7	N	External ADC / DAC Interface (B7)
6	T	SPI Controller 0 (B6)
5	R	SPI Controller 1 (B5)
4	O	PWM generator (B4)
3	L	General Purpose I/O port 0 to 31(B3)
2		General Purpose I/O port 32 to 64 (B2)
1		I2C-master 0 (B1)
0		I2C-master 1 (B0)

Table 633. 0x0x80005194 - APB3PROT3 - APB Control 3 Protection register 3

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	R	R	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	R	R	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	r	r	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	r	r	rW	rW	rW	rW	rW	rW	rW	rW

31		Generic UART 0 (A15)
30	D	Generic UART 1 (A14)
29	M	Generic UART 2 (A13)
28	A	Generic UART 3 (A12)
27	2	Generic UART 4 (A11)
26		Generic UART 5 (A10)
25	C	unused
23	O	unused
24	N	External ADC / DAC Interface (A7)
22	T	SPI Controller 0 (A6)
21	R	SPI Controller 1 (A5)
20	O	PWM generator (A4)
19	L	General Purpose I/O port 0 to 31 (A3)
18		General Purpose I/O port 32 to 64 (A2)
17		I2C-master 0 (A1)
16		I2C-master 1 (A0)
15		Generic UART 0 (B15)
14	D	Generic UART 1 (B14)
13	M	Generic UART 2 (B13)
12	A	Generic UART 3(B12)
11	3	Generic UART 4 (B11)
10		Generic UART 5 (B10)
9	C	unused
8	O	unused
7	N	External ADC / DAC Interface (B7)
6	T	SPI Controller 0 (B6)
5	R	SPI Controller 1 (B5)
4	O	PWM generator (B4)
3	L	General Purpose I/O port 0 to 31(B3)
2		General Purpose I/O port 32 to 64 (B2)
1		I2C-master 0 (B1)
0		I2C-master 1 (B0)

# LEON3FT Microcontroller

## 47.3.5 Protection register for AMBA APB 4

This subsection specifies access control registers for peripherals and registers accessible 0x80400000 to 0x8040FFFF.

Table 634. 0x0x800051C0 - APB4PROT0 - APB Control 4 Protection register 0

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
C15	C14	C13	C12	C11	C10	C9	C8	C7	C6	C5	C4	C3	C2	C1	C0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

- 31            ADC0 (C15)
- 30            ADC1 (C14)
- 29    C     ADC2 (C13)
- 28    P     ADC3 (C12)
- 27    U     ADC4 (C11)
- 26            ADC5 (C10)
- 25    C     ADC6 (C9)
- 24    O     ADC7 (C8)
- 23    N     DAC0 (C7)
- 22    T     DAC1 (C6)
- 21    R     DAC2 (C5)
- 20    O     DAC3 (C4)
- 19    L     I2C-slave 0 (C3)
- 18            I2C-slave 1 (C2)
- 17            PWM generator 1 (C1)
- 16            SPI for Space slave (C0)
- 15            ADC0 (B15)
- 14    B     ADC1 (B14)
- 13    R     ADC2 (B13)
- 12    I     ADC3 (B12)
- 11    D     ADC4 (B11)
- 10    G     ADC5 (B10)
- 9     E     ADC6 (B9)
- 8            ADC7 (B8)
- 7     C     DAC0 (B7)
- 6     O     DAC1 (B6)
- 5     N     DAC2 (B5)
- 4     T     DAC3 (B4)
- 3     R     I2C-slave 0 (B3)
- 2     L     I2C-slave 1 (B2)
- 1            PWM generator 1 (B1)
- 0            SPI for Space slave (B0)

Table 635. 0x0x800051C4 - APB4PROT1 - APB Control 3 Protection register 1

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED																B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0																0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
r																rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

31: 16            Not Used

# LEON3FT Microcontroller

Table 635. 0x0x800051C4 - APB4PROT1 - APB Control 3 Protection register 1

15		ADC0 (B15)
14		ADC1 (B14)
13	S	ADC2 (B13)
12	C	ADC3 (B12)
11	R	ADC4 (B11)
10	U	ADC5 (B10)
9	B	ADC6 (B9)
8		ADC7 (B8)
7	C	DAC0 (B7)
6	O	DAC1 (B6)
5	N	DAC2 (B5)
4	T	DAC3 (B4)
3	R	I2C-slave 0 (B3)
2	L	I2C-slave 1 (B2)
1		PWM generator 1 (B1)
0		SPI for Space slave (B0)

Table 636. 0x0x800051E0 - APB4PROT2 - APB Control 4 Protection register 2

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

31		ADC0 (B15)
30	D	ADC1 (B14)
29	M	ADC2 (B13)
28	A	ADC3 (B12)
27	0	ADC4 (B11)
26		ADC5 (B10)
25	C	ADC6 (B9)
23	O	ADC7 (B8)
24	N	DAC0 (B7)
22	T	DAC1 (B6)
21	R	DAC2 (B5)
20	O	DAC3 (B4)
19	L	I2C-slave 0 (B3)
18		I2C-slave 1 (B2)
17		PWM generator 1 (B1)
16		SPI for Space slave (B0)
15		ADC0 (B15)
14	D	ADC1 (B14)
13	M	ADC2 (B13)
12	A	ADC3 (B12)
11	1	ADC4 (B11)
10		ADC5 (B10)
9	C	ADC6 (B9)
8	O	ADC7 (B8)
7	N	DAC0 (B7)
6	T	DAC1 (B6)



# LEON3FT Microcontroller

Table 636. 0x0x800051E0 - APB4PROT2 - APB Control 4 Protection register 2

5	R	DAC2 (B5)
4	O	DAC3 (B4)
3	L	I2C-slave 0 (B3)
2		I2C-slave 1 (B2)
1		PWM generator 1 (B1)
0		SPI for Space slave (B0)

Table 637. 0x0x800051E4 - APB4PROT3 - APB Control 4 Protection register 3

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0
rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW	rW

31		ADC0 (B15)
30	D	ADC1 (B14)
29	M	ADC2 (B13)
28	A	ADC3 (B12)
27	2	ADC4 (B11)
26		ADC5 (B10)
25	C	ADC6 (B9)
23	O	ADC7 (B8)
24	N	DAC0 (B7)
22	T	DAC1 (B6)
21	R	DAC2 (B5)
20	O	DAC3 (B4)
19	L	I2C-slave 0 (B3)
18		I2C-slave 1 (B2)
17		PWM generator 1 (B1)
16		SPI for Space slave (B0)
15		ADC0 (B15)
14	D	ADC1 (B14)
13	M	ADC2 (B13)
12	A	ADC3 (B12)
11	3	ADC4 (B11)
10		ADC5 (B10)
9	C	ADC6 (B9)
8	O	ADC7 (B8)
7	N	DAC0 (B7)
6	T	DAC1 (B6)
5	R	DAC2 (B5)
4	O	DAC3 (B4)
3	L	I2C-slave 0 (B3)
2		I2C-slave 1 (B2)
1		PWM generator 1 (B1)
0		SPI for Space slave (B0)

# LEON3FT Microcontroller

## 47.3.6 DMA protection register description

This chapter specifies access control registers for peripherals and registers accessible 0x30000000 to 0x31FFFFFF.

Table 638. 0x8010A000 - PCR - Protection Configuration register

31	24 23	4 3	1 0
NSEG	Reserved	PROT	EN
0x4	0x0	0x0	1
r	r	rw	rw

- 31: 24      NSEG - Number of segments supported.
- 23: 4      Reserved
- 3: 1      PROT - Protection of memory control access. This bit field needs to be set to 101b in order to be able to change any register configuration of the memory protection.
- 0      EN - Enable Memory Protection of specified memory segments. This bit can be used to enable and disable all protected segments at the same-time. This bit is enabled at startup and individual segment can be controlled via separate segment control registers

Table 639. 0x8010A004 + segment\*0x10 - PSA - Protection Segment Start Address register

31	0
SADDR	
0x0	
rw	

- 31: 0      SADDR - Start address of segment. Start address should be in the range 0x30000000 to 0x31FFFFFF.

Table 640. 0x8010A5008 + segment\*0x10 - PEA - Protection Segment End Address register

31	0
EADDR	
0x0	
rw	

- 31: 0      EADDR - End address of segment. End address should be in the range 0x30000000 to 0x31FFFFFF.

# LEON3FT Microcontroller

Table 641. 0x8010A00C + segment\*0x10 - PSC - Protection Segment Control register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	Reserved		1	0
G15	G14	G13	G12	G11	G10	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	Reserved				EN
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0				0
rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r				rw

- 31 G15 - Grant SPI4S on the DMA bus exclusive write permission
- 30 G14 - Grant DMA controller #3 on the DMA bus exclusive write permission
- 29 G13 - Grant DMA controller #2 on the DMA bus exclusive write permission
- 28 G12 - Grant DMA controller #1 on the DMA bus exclusive write permission
- 27 G11 - Grant DMA controller #0 on the DMA bus exclusive write permission
- 26 G10 - Grant PacketWire transmitter on the DMA bus exclusive write permission
- 25 G9 - Grant PacketWire receiver on the DMA bus exclusive write permission
- 24 G8 - Grant Bridge from System bus exclusive write permission.
- 23 G7 - Grant UART on the DMA bus exclusive write permission
- 22 G6 - Grant CAN on the DMA bus exclusive write permission
- 21 G5 - Grant CAN on the DMA bus exclusive write permission
- 20 G4 - Grant I2C on the DMA bus exclusive write permission
- 19 G3 - Grant SPI on the DMA bus exclusive write permission
- 18 G2 - Grant SpaceWire on the DMA bus exclusive write permission
- 17 G1 - Grant MIL-1553 on the DMA bus exclusive write permission.
- 16 G0 - Grant Bridge from Debug bus exclusive write permission.
- 15: 1 RESERVED
- 0 EN - Enable Memory Protection for specified memory segments. This bit will grant exclusive write permission to specified masters within protected memory segment

## 47.4 Example of configure and use the Memory protection

This chapter gives examples how of the memory protection unit can be used

### 47.4.1 Protect local instruction memory

To protect the local instruction memory from any erroneously writes during normal operation the protected area start and stop address should be specified and the master given access to the protected area: (For this example we use segment number #0 but any segment can be used for protection)

```
PSA0.SADDR = 0x31000000
PSA0.SADDR = 0x3100FFFF
PSAC0.GRANT = 0x0000
PSAC0.EN = 0x1
PCR.EN = 0x1
```

This example defines the protected area, grants no master access to the area and enable segment end global protection.

### 47.4.2 Protect external SRAM memory

To protect an area in the external SRAM memory from any erroneously writes during normal operation the protected area start and stop address should be specified and the master given access to the protected area: (For this example we use segment number #0 but any segment can be used for protection)

```
PSA0.SADDR = 0x40100000
```

# LEON3FT Microcontroller

---

```

PSA0.SADDR           =           0x401FFFFF
PSAC0.GRANT          =           0x0000
PSAC0.EN             =           0x1
PCR.EN = 0x1
  
```

This example defines the protected area, grants no master access to the area and enable segment end global protection.

To give a AMBA master access to the protected area change the value in the register PSAC0.GRANT to e.g. 0x0002 to give access to masters accessing the system AMBA bus via the AHB2AHB bridge from the DMA AMBA bus.

### 47.4.3 Protect clock gating unit from erroneous accesses

To protect the clock gating from erroneous access the APB bridge can be programmed to deny all write accesses or to grant privilege access to specific AMBA bus masters.

The clock gating unit 1 and 2 are located on APB bus 1 and access to clock gating unit 1 and 2 are controlled via register APB0PROT0, APB1PROT1, APBPROT2 and APBPROT3.

To deny all DMA controllers access:

```

APB1PROT2.A9         =           0x1
APB1PROT2.A10        =           0x1
APB1PROT2.B9         =           0x1
APB1PROT2.B10        =           0x1
APB1PROT3.A9         =           0x1
APB1PROT3.A10        =           0x1
APB1PROT3.B9         =           0x1
APB1PROT3.B10 = 0x1
  
```

# LEON3FT Microcontroller

## 48 Serial Debug and Remote Access Interface

The GR716 microcontroller comprises two debug and remote access UART units. The UART units described in this section have the capability to respond on external UART signaling and act as a master on the internal bus without software support. The capability to respond to external access without software support differentiates the two remote access UART units from the regular UART units described in chapter 19.

The first unit (AHBUART0) is directly connected to AMBA debug bus and the second unit (AHBUART1) is connected to the DMA AMBA bus. Each unit have a unique AMBA address described in chapter 2.10 for configuration and status.

The first unit is the main debug interface during software development and have direct access to the internal state of the processor and trace buffers. This interface can be disabled during mission via external pin configuration i.e. tie DSU\_EN to low.

The second unit is to be used for remote access of the GR716 microcontroller in mission mode i.e. when DSU\_EN is low. The second unit is available via the IO switch matrix described in chapter 2.5. The second UART remote access unit is setup via boot straps.

The control and status register for the units are located on APB bus in the address range from 0x8000F000 to 0x8000FFFF and in the range from 0x94000000 to 0x9400FFF. See serial debug and remote access interface units connections in the next drawing. The figure shows memory locations and functions used for interfaces configuration and control.

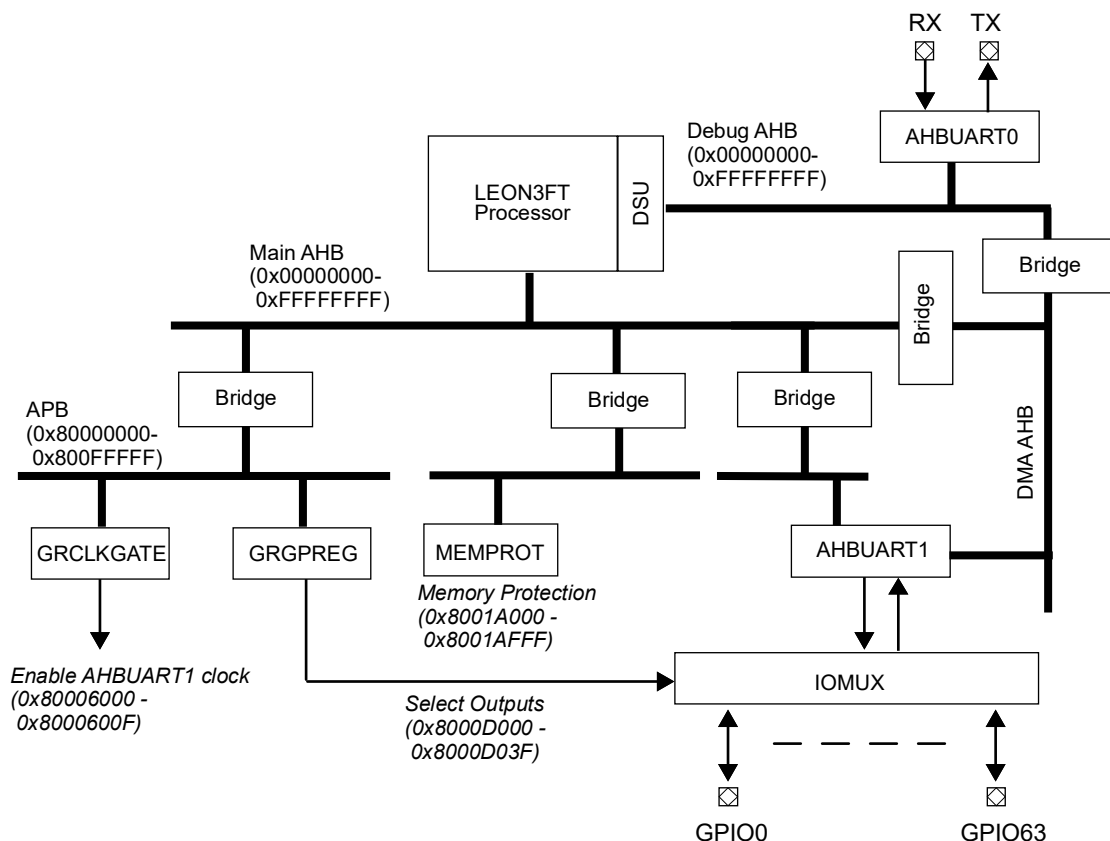


Figure 95. GR716 AHBUARTx bus and pin connection

The primary clock gating unit **GRCLKGATE** described in section 27 is used to enable/disable the AHBUART1. The unit **GRCLKGATE** can also be used to perform reset of the AHBUART1 unit.

# LEON3FT Microcontroller

Software must enable clock and release reset described in section 27 before configuration and transmission can start.

External IO selection and configuration is made in the system IO configuration registers (**GRG-PREG**) in the address range from 0x8000D000 to 0x8000D03F. See section 7.1

The system can be configured to protect and restrict access to the AHBUART1 unit in the **MEM-PROT** unit. For more information See section 47 for more information.

## 48.1 Overview

Each interface consists of a UART connected to the AMBA AHB bus as a master. A simple communication protocol is supported to transmit access parameters and data. Through the communication link, a read or write transfer can be generated to any address on the AMBA AHB bus.

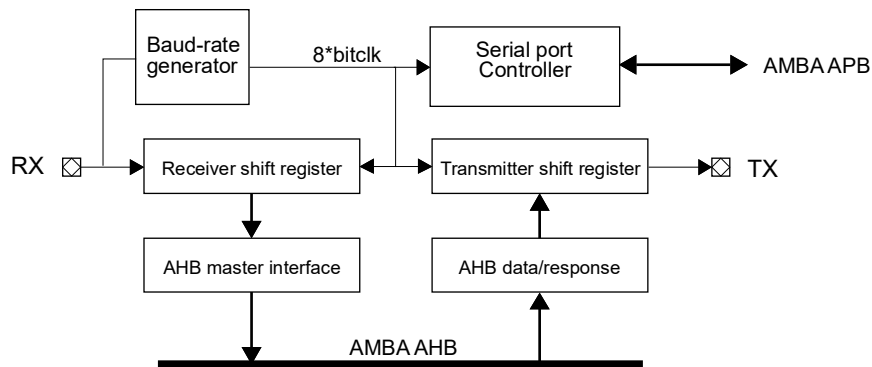


Figure 96. Block diagram

# LEON3FT Microcontroller

## 48.2 Operation

### 48.2.1 Transmission protocol

The interface supports a simple protocol where commands consist of a control byte, followed by a 32-bit address, followed by optional write data. Write access does not return any response, while a read access only returns the read data. Data is sent on 8-bit basis as shown below.

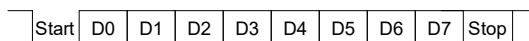


Figure 97. Data frame

#### Write Command



#### Read command

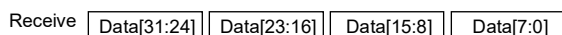


Figure 98. Commands

Block transfers can be performed by setting the length field to n-1, where n denotes the number of transferred words. For write accesses, the control byte and address is sent once, followed by the number of data words to be written. The address is automatically incremented after each data word. For read accesses, the control byte and address is sent once and the corresponding number of data words is returned.

### 48.2.2 Baud rate generation

The UART contains a 18-bit down-counting scaler to generate the desired baud-rate. The scaler is clocked by the system clock and generates a UART tick each time it underflows. The scaler is reloaded with the value of the UART scaler reload register after each underflow. The resulting UART tick frequency should be 8 times the desired baud-rate.

If not programmed by software, the baud rate will be automatically discovered. This is done by searching for the shortest period between two falling edges of the received data (corresponding to two bit periods). When three identical two-bit periods has been found, the corresponding scaler reload value is latched into the reload register, and the BL bit is set in the UART control register. If the BL bit is reset by software, the baud rate discovery process is restarted. The baud-rate discovery is also restarted when a 'break' or framing error is detected by the receiver, allowing to change to baudrate from the external transmitter. For proper baudrate detection, the value 0x55 should be transmitted to the receiver after reset or after sending break.

The best scaler value for manually programming the baudrate can be calculated as follows:

$$\text{scaler} = ((\text{system\_clk} * 10) / (\text{baudrate} * 8)) - 5) / 10$$

# LEON3FT Microcontroller

## 48.3 Registers

The core is programmed through registers mapped into APB address space.

Table 642. AHB UART registers

APB address offset	Register
0x4	AHB UART status register
0x8	AHB UART control register
0xC	AHB UART scaler register

### 48.3.1 AHB UART control register

Table 643. 0x08 - CTRL - AHB UART control register

31		2	1	0
RESERVED			BL	EN
0			0	0
r			r	rw

- 0: Receiver enable (EN) - if set, enables both the transmitter and receiver. Reset value: '0'.
- 1: Baud rate locked (BL) - is automatically set when the baud rate is locked. Reset value: '0'.

### 48.3.2 AHB UART status register

Table 644. 0x04 - STAT - AHB UART status register

31		10	9	8	7	6	5	4	3	2	1	0		
RESERVED						TCNT	RX	FE	R	OV	BR	TH	TS	DR
0						0	MR	0	0	0	0	1	1	0
r						r	r	rw	r	rw	rw	r	r	r

- 0: Data ready (DR) - indicates that new data has been received by the AMBA AHB master interface. Read only. Reset value: '0'.
- 1: Transmitter shift register empty (TS) - indicates that the transmitter shift register is empty. Read only. Reset value: '1'
- 2: Transmitter hold register empty (TH) - indicates that the transmitter hold register is empty. Read only. Reset value: '1'
- 3: Break (BR) - indicates that a BREAK has been received. Reset value: '0'
- 4: Overflow (OV) - indicates that one or more character have been lost due to receiver overflow. Reset value: '0'
- 6: Frame error (FE) - indicates that a framing error was detected. Reset value: '0'
- 7: Input state (RX) - Filtered input state
- 9: 8 Counter State (TCNT) - Internal Counter state

### 48.3.3 AHB UART scaler register

Table 645. 0x0C - SCALER - AHB UART scaler register

31		18	17	0
RESERVED			SCALER RELOAD VALUE	
0			0x3FFFB	



# LEON3FT Microcontroller

Table 645.0x0C - SCALER - AHB UART scaler register

r	rw
---	----

17: 0      Baudrate scaler reload value =  $\frac{((\text{system\_clk} * 10) / (\text{baudrate} * 8)) - 5}{10}$ . Reset value: “3FFFF”.

# LEON3FT Microcontroller

## 49 AHB Status Registers

The GR716 microcontroller have 2 separate AHB Status Register units (AHBSTAT).

The 2 separate AHB Status Register units AHBSTAT0 and AHBSTAT1 monitors the DMA bus and the system bus respectively for accesses triggering an error response.

Each AHB Status Register unit (AHBSTATx) have a unique AMBA address described in chapter 2.10 for configuration and status.

The AHB Status Register units are located on APB bus in the address range from 0x8000A000 to 0x8000AFFF and 0x80306000 to 0x80306FFF.

See units connections in the next drawing. The drawing picture memory locations and functions used for configuration and control.

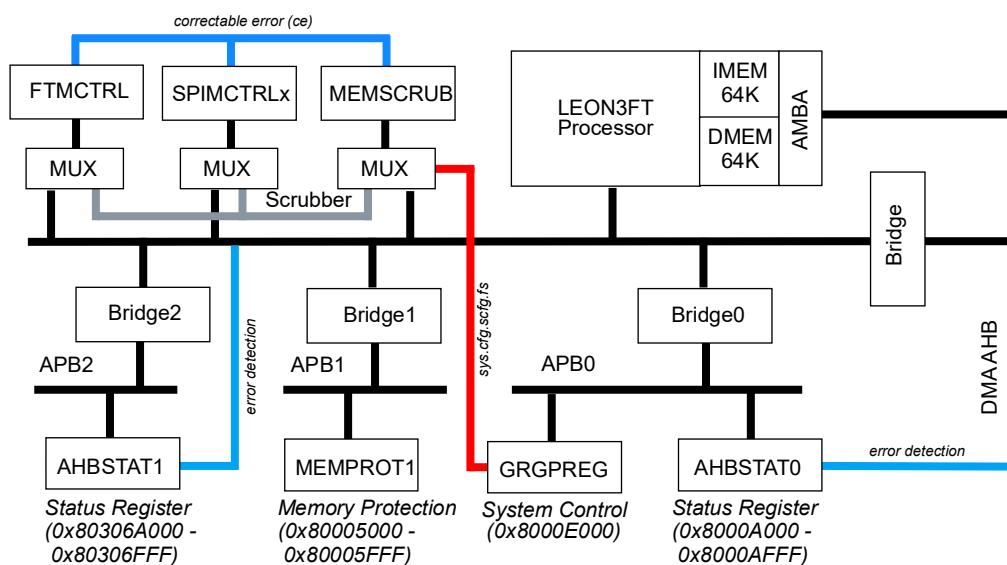


Figure 99. GR716 Status Register bus connection

AHBSTAT unit 0 and 1 has identical configuration and status register. Configuration and status registers are describe in this section 49.3.

System can be configured to protect and restrict access to individual AHBSTAT units in the MEMPROT unit. See section 47 for more information.

### 49.1 Overview

The status registers store information about AMBA AHB accesses triggering an error response. There is a status register and a failing address register capturing the control and address signal values of a failing AMBA bus transaction, or the occurrence of a correctable error being signaled from a fault tolerant core.

### 49.2 Operation

#### 49.2.1 Errors

The registers monitor AMBA AHB bus transactions and store the current HADDR, HWRITE, HMASTER and HSIZE internally. The monitoring are always active after startup and reset until an error response (HRESP = "01") is detected. When the error is detected, the status and address register

# LEON3FT Microcontroller

contents are frozen and the New Error (NE) bit is set to one. At the same time an interrupt is generated, as described hereunder.

Note that many of the fault tolerant units containing EDAC signal an un-correctable error as an AMBA error response, so that it can be detected by the processor as described above.

## 49.2.2 Correctable errors

Not only error responses on the AHB bus can be detected. Many of the fault tolerant units containing EDAC have a correctable error signal which is asserted each time a correctable error is detected. When such an error is detected, the effect will be the same as for an AHB error response. The only difference is that the Correctable Error (CE) bit in the status register is set to one when a correctable error is detected.

When the CE bit is set the interrupt routine can acquire the address containing the correctable error from the failing address register and correct it. When it is finished it resets the NE bit and the monitoring becomes active again. Interrupt handling is described in detail hereunder.

## 49.2.3 Interrupts

The interrupt is connected to the interrupt controller to inform the processor of the error condition. The normal procedure is that an interrupt routine handles the error with the aid of the information in the status registers. When it is finished it resets the NE bit and the monitoring becomes active again. Interrupts are generated for both AMBA error responses and correctable errors as described above.

## 49.2.4 Filtering and multiple error detection

The status register can optionally be implemented with two sets of status and failing address register. In this case the core also supports filtering on errors and has a status bit that gets set in case additional errors are detected when the New Error (NE) bit is set. The core will only react to the first error in a burst operation. After the first error has been detected, monitoring of the burst is suspended.

An error event will only be recorded by the first status register that should react based on filter settings. If register set 1 has reacted then register 2 will not be set for the same error event. In the case where an error occurs and all register sets that could have recorded an error, based on filter settings, already have the NE bit set then the ME bit will be set for all the matching register sets.

## 49.3 Registers

The core is programmed through registers mapped into APB address space.

Table 646. AHB Status registers

APB address offset	Registers
<i>AHB Status Register unit #1 (AHBSTAT1)</i>	
0x8000A000	AHB Status register
0x8000A004	AHB Failing address register
0x8000A008	AHB Status register 2
0x8000A00C	AHB Failing Address register 2
<i>AHB Status Register unit #1 (AHBSTAT2)</i>	
0x80306000	AHB Status register
0x80306004	AHB Failing address register
0x80306008	AHB Status register 2
0x8030600C	AHB Failing Address register 2

# LEON3FT Microcontroller

## 49.3.1 AHB Status register

Table 647. 0x00, 0x08- AHBS - AHB Status register

31		14	13	12	11	10	9	8	7	6	3	2	0
	RESERVED		ME	FW	CF	AF	CE	NE	HWRITE	HMASTER	HSIZE		
	0		0	0	0	0	0	0	NR	NR	NR		
	r		rw*	w*	rw*	rw*	rw	rw	r	r	r		

- 31: 14      RESERVED
- 13          Multiple Error detection (ME) - This field is set to 1 when the New Error bit is set and one more error is detected. Filtering is considered when setting the ME bit.  
This field is only available in version 1 of the core (version is selected at implementation).
- 12          Filter Write (FW) - This bit needs to be set to '1' during a write operation for CF and AF fields to be updated in the same write operation. Always reads as zero.  
This field is only available in version 1 of the core (version is selected at implementation).
- 11          Correctable Error Filter (CF) - If this bit is set to 1 then this status register will ignore correctable errors. This field will only be written if the FW bit is set.  
This field is only available in version 1 of the core (version is selected at implementation).
- 10          AMBA ERROR Filter (AF) - If this bit is set to 1 then this status register will ignore AMBA ERROR. This field will only be written if the FW bit is set.  
This field is only available in version 1 of the core (version is selected at implementation).
- 9            Correctable Error (CE) - Set if the detected error was caused by a correctable error and zero otherwise.
- 8            New Error (NE) - Deasserted at start-up and after reset. Asserted when an error is detected. Reset by writing a zero to it.
- 7            The HWRITE signal of the AHB transaction that caused the error.
- 6: 3        The HMASTER signal of the AHB transaction that caused the error.
- 2: 0        The HSIZE signal of the AHB transaction that caused the error

## 49.3.2 AHB Failing address register

Table 648. 0x04, 0x0C - AHB FAR - AHB Failing address register

31	0
AHB FAILING ADDRESS	
NR	
t	

- 31: 0          The HADDR of the AHB transaction that caused the error.

# LEON3FT Microcontroller

## 50 Trace buffer

The GR716 microcontroller have 2 separate AMBA trace buffer (AHBTRACE) units. The AHBTRACE units described in this section have the capability to trace all transactions on the main AHB bus and Debug AHB bus.

The first AMBA trace buffer (AHBTRACE0) is tracing the Main AHB bus and the second AMBA trace buffer (AHBTRACE1) is tracing the DMA AMBA bus. Each AMBA trace buffer (AHBTRACE) unit have a unique AMBA address described in chapter 2.10 for configuration and status.

The control and status register for the AMBA trace buffer units are located on AHB bus in the address range from 0x90000000 to 0x907FFFFFFF and in the range from 0x9FF20000 to 0x9FF3FFFF. See AMBA memory protection units connections in the next drawing. The drawing picture memory locations and functions used for AMBA memory protection units configuration and control.

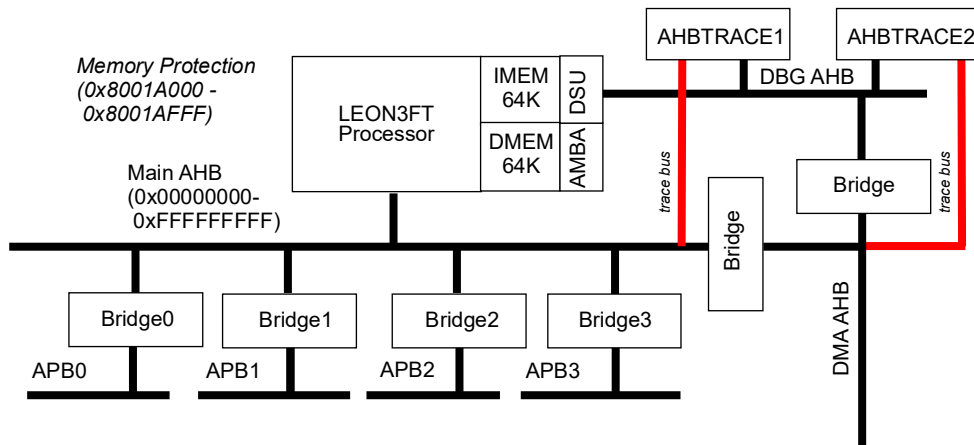


Figure 100. GR716 AHBTRACEx bus and pin connection

AHBTRACE unit 0 and 1 has identical configuration and status register. Configuration and status registers for AHBTRACE1 are describe in this section 50.4 and register for AHBTRACE0 is embedded into DSU3 described in section 20.7.

### 50.1 Overview

The trace buffer consists of a circular buffer that stores AMBA AHB data transfers. The user can select to trace the main bus, DMA bus, Debug bus or Scrubber bus. The address, data and various control signals of the selected AHB bus are stored and can be read out for later analysis.

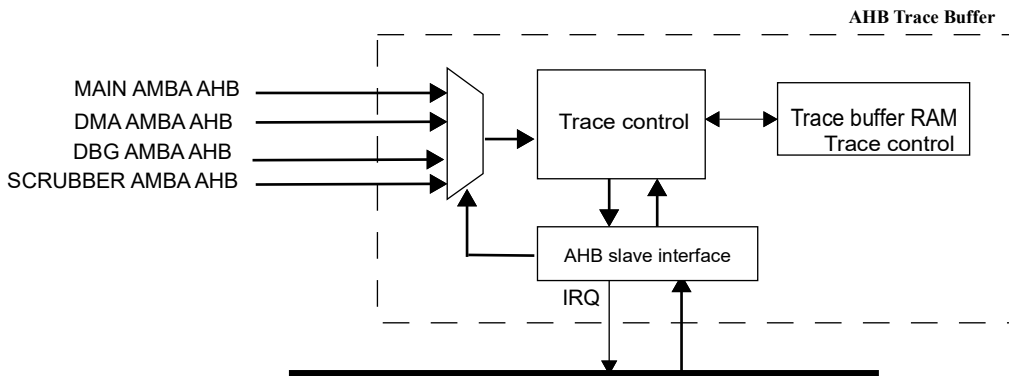


Figure 101. Block diagram

# LEON3FT Microcontroller

When the trace buffer is configured to store the information as indicated in the table below:

Table 649. AHB Trace buffer data allocation

Bits	Name	Definition
127:96	Time tag	The value of the time tag counter
95	AHB breakpoint hit	Set to '1' if a DSU AHB breakpoint hit occurred.
94:80	-	Not used
79	Hwrite	AHB HWRITE
78:77	Htrans	AHB HTRANS
76:74	Hsize	AHB HSIZE
73:71	Hburst	AHB HBURST
70:67	Hmaster	AHB HMASTER
66	Hmastlock	AHB HMASTLOCK
65:64	Hresp	AHB HRESP
63:32	Load/Store data	AHB HRDATA[31:0] or HWDATA[31:0]
31:0	Load/Store address	AHB HADDR

In addition to the AHB signals, a 32-bit counter is also stored in the trace as time tag.

## 50.2 Operation

### 50.2.1 Overview

The trace buffer is enabled by setting the enable bit (EN) in the trace control register. Each AMBA AHB transfer is then stored in the buffer in a circular manner. The address to which the next transfer is written is held in the trace buffer index register, and is automatically incremented after each transfer. Tracing is stopped when the EN bit is reset, or when a AHB breakpoint is hit. An interrupt is generated when a breakpoint is hit.

### 50.2.2 AHB statistics

The trace module generates statistics from the traced AHB bus. Statistics is collected and output to LEON statistics unit (L3STAT). The statistical outputs can be filtered by the AHB trace buffer filters, this is controlled by the Performance counter Filter bit (PF) in the AHB trace buffer control register. The core can collect data for the events listed in table 650 below.

Table 650. AHB events

Event	Description	Note
idle	HTRANS=IDLE	Active when HTRANS IDLE is driven on the AHB slave inputs and slave has asserted HREADY.
busy	HTRANS=BUSY	Active when HTRANS BUSY is driven on the AHB slave inputs and slave has asserted HREADY.
nseq	HTRANS=NONSEQ	Active when HTRANS NONSEQ is driven on the AHB slave inputs and slave has asserted HREADY.
seq	HTRANS=SEQ	Active when HTRANS SEQUENTIAL is driven on the AHB slave inputs and slave has asserted HREADY.
read	Read access	Active when HTRANS is SEQUENTIAL or NON-SEQUENTIAL, slave has asserted HREADY and the HWRITE input is low.
write	Write access	Active when HTRANS is SEQUENTIAL or NON-SEQUENTIAL, slave has asserted HREADY and the HWRITE input is high.

# LEON3FT Microcontroller

Table 650. AHB events

Event	Description	Note
hsize[5:0]	Transfer size	Active when HTRANS is SEQUENTIAL or NON-SEQUENTIAL, slave has asserted HREADY and HSIZE is BYTE (hsize[0]), HWORD (HSIZE[1]), WORD (hsize[2]), DWORD (hsize[3]), 4WORD hsize[4], or 8WORD (hsize[5]).
ws	Wait state	Active when HREADY input to AHB slaves is low and AMBA response is OKAY.
retry	RETRY response	Active when master receives RETRY response
split	SPLIT response	Active when master receives SPLIT response
spdel	SPLIT delay	Active during the time a master waits to be granted access to the bus after reception of a SPLIT response. The core will only keep track of one master at a time. This means that when a SPLIT response is detected, the core will save the master index. This event will then be active until the same master is re-allowed into bus arbitration and is granted access to the bus. This also means that the delay measured will include the time for re-arbitration, delays from other ongoing transfers and delays resulting from other masters being granted access to the bus before the SPLIT:ed master is granted again after receiving SPLIT complete.  If another master receives a SPLIT response while this event is active, the SPLIT delay for the second master will not be measured.
locked	Locked access	Active while the HMASTLOCK signal is asserted on the AHB slave inputs. (Currently not used by L3STAT and L4STAT)

## 50.3 Using the AHB trace buffer

The debug monitor GRMON3 has build-in support for using AHB trace buffer. For more information see chapter for using the trace buffer in the GRMON3 User's Manual [GRMON3].

# LEON3FT Microcontroller

## 50.4 Registers

### 50.4.1 Register address map

The trace buffer occupies 128 KiB of address space in the AHB I/O area. The following register addresses are decoded:

Table 651. Trace buffer address space

Address	Register
0x000000	Trace buffer control register
0x000004	Trace buffer index register
0x000008	Time tag counter
0x00000C	Trace buffer master/slave filter register
0x000010	AHB break address 1
0x000014	AHB mask 1
0x000018	AHB break address 2
0x00001C	AHB mask 2
0x010000 - 0x020000	Trace buffer
...0	Trace bits 127 - 96
...4	Trace bits 95 - 64
...8	Trace bits 63 - 32
...C	Trace bits 31 - 0

### 50.4.2 Trace buffer control register

The trace buffer is controlled by the trace buffer control register:

Table 652. 0x000000 - CTRL - Trace buffer control register

31	23	22	16	15	14	12	11	9	8	7	6	5	4	3	2	1	0
RESERVED			DCNT		BA	BSEL	RESERVED	PF	BW	RF	AF	FR	FW	DM	EN		
0			0		1	0	0	0	*	0	0	0	0	0	0	*	
r			rw		r	rw	r	rw	r	rw	rw	rw	rw	r	rw		

- 31: 23 RESERVED
- 22: 16 Trace buffer delay counter (DCNT)
- 15 Bus select Available (BA) - Set to '1' to indicate that the core has several buses connected. The bus to trace is selected via the BSEL field.
- 14: 12 Bus select (BSEL)  
 "000" - Main AHB Bus  
 "001" - DMA AHB bus  
 "010" - Debug AHB bus  
 "011" - Scrubber AHB bus
- 11: 9 RESERVED
- 8 Performance counter Filter (PF) - If this bit is set to '1', the cores performance counter (statistical) outputs will be filtered using the same filter settings as used for the trace buffer. If a filter inhibits a write to the trace buffer, setting this bit to '1' will cause the same filter setting to inhibit the pulse on the statistical output.
- 7: 6 Bus width (BW) - This value corresponds to  $\log_2(\text{Supported bus width} / 32)$
- 5 Retry filter (RF) - If this bit is set to '1', AHB retry responses will not be included in the trace buffer.
- 4 Address Filter (AF) - If this bit is set to '1', only the address range defined by AHB trace buffer breakpoint 2's address and mask will be included in the trace buffer.
- 3 Filter Reads (FR) - If this bit is set to '1', read accesses will not be included in the trace buffer.
- 2 Filter Writes (FW) - If this bit is set to '1', write accesses will not be included in the trace buffer.



# LEON3FT Microcontroller

Table 652.0x000000 - CTRL - Trace buffer control register

1	Delay counter mode (DM) - Indicates that the trace buffer is in delay counter mode.
0	Trace enable (EN) - Enables the trace buffer

### 50.4.3 Trace buffer index register

The trace buffer index register indicates the address of the next 128-bit line to be written.

Table 653.0x000004 - INDEX - Trace buffer index register

31		11 10		4 3	0
	RESERVED		INDEX		0x0
	0		NR		0
	r		rw		r

31: 11	RESERVED
10: 4	Trace buffer index counter (INDEX).
3: 0	Read as 0x0

### 50.4.4 Trace buffer time tag register

The time tag register contains a 32-bit counter that increments each clock when the trace buffer is enabled. The value of the counter is stored in the trace to provide a time tag.

Table 654.0x000008 - TIMETAG - Trace buffer time tag counter

31		0
	TIME TAG VALUE	
	0	
	r	

### 50.4.5 Trace buffer master/slave filter register

The master/slave filter register allows filtering out specified master and slaves from the trace.

Table 655. Trace buffer master/slave filter register

31		16 15		0
	SMASK[15:0]		MMASK[15:0]	
	0		0	
	rw		rw	

31: 16	Slave Mask (SMASK) - If SMASK[n] is set to '1', the trace buffer will not save accesses performed to slave n.
15: 0	Master Mask (MMASK) - If MMASK[n] is set to '1', the trace buffer will not save accesses performed by master n.

# LEON3FT Microcontroller

## 50.4.6 Trace buffer breakpoint registers

The DSU contains two breakpoint registers for matching AHB addresses. A breakpoint hit is used to freeze the trace buffer by clearing the enable bit. Freezing can be delayed by programming the DCNT field in the trace buffer control register to a non-zero value. In this case, the DCNT value will be decremented for each additional trace until it reaches zero and after two additional entries, the trace buffer is frozen. A mask register is associated with each breakpoint, allowing breaking on a block of addresses. Only address bits with the corresponding mask bit set to '1' are compared during breakpoint detection. To break on AHB load or store accesses, the LD and/or ST bits should be set.

Table 656. Trace buffer AHB breakpoint address register

31		2	1	0
	BADDR[31:2]			0b00
	NR			0
	rw			r

- 31: 2      Breakpoint address (BADDR) - Bits 31:2 of breakpoint address
- 1: 0      Reserved, read as 0

Table 657. Trace buffer AHB breakpoint mask register

31		2	1	0
	BMASK[31:2]		LD	ST
	NR		0	0
	rw		rw	rw

- 31: 2      Breakpoint mask (BMASK) - Bits 31:2 of breakpoint mask
- 1          Load (LD) - Break on data load address
- 0          Store (ST) - Break on data store address

# LEON3FT Microcontroller

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## 51 Boot ROM

### 51.1 Overview

The GR716B microcontroller contains a on-chip Boot ROM for low-level initialization and optional self-testing, standby and application loading. The Boot ROM contains instructions executed by the CPU. The Boot ROM may be configured via bootstraps signals controlled by the user at reset.

The Boot ROM prepares an execution environment suitable for an Application Software (ASW) to take over the system. This reduces the system initialization normally required by the application to perform.

It is possible to disable the Boot ROM via bootstraps signals, see section 7.1. When the Boot ROM is disabled, the reset address is determined by bootstrap signals. Note that in this case boot ing from I2C PROM is not supported.

# LEON3FT Microcontroller

## 51.2 ROM Architecture

### 51.2.1 Logical division of Boot ROM

This section describes the top-level structure of the Boot ROM. The design is logically divided in three main parts:

- Processor module initialization
- Standby mode
- Load sequence

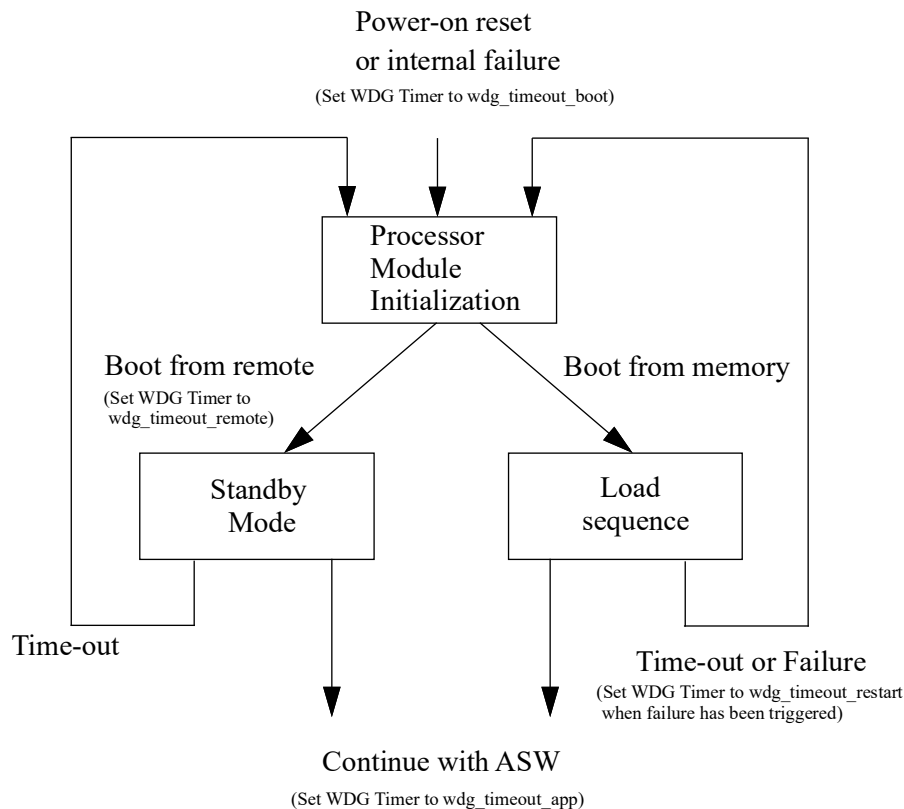


Figure 102. Boot ROM to-level architecture

The *Processor Module Initialization* sequence is triggered by reset condition. It is responsible for initializing and self-testing of on-chip instruction and data memory, writing the boot report. Processor module initialization has a mostly linear execution path, meaning that a minimum number of branch decisions which depend on system external factors are made. Initialization sequence is directly followed by the standby mode or load sequence.

The *Standby mode* is entered when the GR716B microcontroller is configured via bootstraps to be configured remotely via external interface, for example SpW, SPI, UART, etc. The watchdog timer is initialized.

The *Loading sequence* is responsible for validating, loading and executing an ASW image residing in application storage memory (ASM) or RAM. After the ASW load the ASW will be executed.

# LEON3FT Microcontroller

## 51.2.2 Properties of the Boot ROM

The table below gives an overview of certain properties of the Boot ROM. Some parameters are given in seconds based on a 50MHz system clock, however they must be scaler to the actual system clock to get the correct number of seconds.

Table 658.Run-time properties

Name	Value	Description
gptimer_prescaler	50000	Initialization value for GPTIMER prescaler reload. This value shall be set to generate a 1 second timer tick frequency. (At 50MHz system clock)
wdg_timeout_boot	360	Timeout, in seconds, for the watchdog timer during start of internal boot. (At 50MHz system clock)
wdg_timeout_restart	1	Timeout, in seconds, for the watchdog timer when an internal error has occurred. (At 50MHz system clock)
wdg_timeout_app	600	Timeout, in seconds, set prior to application hand over from Boot ROM. (At 50MHz system clock)
wdg_timeout_remote	5*3600	Timeout, in seconds, waiting for remote access. (At 50MHz system clock)
i2c_prescaler	-	Prescaler set for 100KHz transfer for 50MHz system clock
i2c_deviceid	0x50	I2C device ID is locked to 0x50
mcfg1, mcfg2, mcfg3 - Initialization value for external memory controller		
mcfg1_r_ws	0xF	max read PROM wait states
mcfg1_bsize	0x6	Prom banks size of 512KiB
mcfg2_r_ws	0x4	max read SRAM wait states
mcfg2_bsize	0x6	Sram banks size of 512KiB
%psr, %wim and %tbr settings for applications and remote boot mode		
PSR_SUPER	0x1	Enable Supervisor mode
PSR_CWP	0x0	Default CWP
PSR_PIL	0x0	Processor interrupt level for application and remote access
PIL_EF	0x0	FPU disabled
fp_start	0x3000FF00	Frame pointer
sp_start	0x3000FEA6	Stack pointer
boot_image_header	0x3000FF48	Boot image header start
boot_report	0x3000FFF8	Boot report start

# LEON3FT Microcontroller

## 51.2.3 Clock configuration

This section specifies the clocks registers used and enabled after boot depending upon the bootstraps.

Table 659: Clock configuration

Mode	PLL Config	Clock Unit	Description
External SPI ROM	N/a	CLKEN0.S0 CLKEN0.S1 <sup>1)</sup>	Boot from external SPI PROM with or without redundant source
External SRAM		CLKEN0.MC	Boot from external SRAM with or without redundant source
External ROM/PROM		CLKEN0.MC	Boot from external SRAM with or without redundant source
External NVRAM		CLKEN0.MC	Boot from external NVRAM with or without redundant source
SpaceWire	PLLREF.CFG 3)	CLKEN0.TD	Remote boot via SpaceWire
SPI4S		CLKEN0.SP	Remote boot via SPI4S
CAN-FD		CLKEN0.IA	Remote boot via CANOpen
UART		CLKEN0.SA	Remote boot via UART

Note 1: Only enabled if boot from primary option fails

Note 2: Table only specify bits enabled by boot. All other bits will remain as is after reset.

Note 3: SpaceWire PLL option is configured by is determined by GPIO[63] and DUART\_TX. For more information see table 20 in section 3.1.

## 51.2.4 Memory Layout

The Boot PROM usage of the memory resources in table 660.

Table 660.Boot software usage of the memory resources

Memory	Properties	Context
Boot memory	Read-only	Boot software executable and constant data
On-chip RAM	Volatile R/W	Boot software volatile runtime data and stack. Used by processor module initialization, load sequence and standby mode. Boot report will be written into the on-chip RAM above the stack.
External PROM/SRAM (FTMCTRL)	Non-Volatile R/W Volatile R/W	Application software, runtime and stack.
External SPI Memory (SPIMCTRL)	Non-Volatile R/W	Application software to be copied into the on-chip RAM and executed from on-chip RAM (Application software can be available at two different areas for dual module redundancy check)

## 51.2.5 Boot report

Boot report entries are written by the Boot SW. The boot report in combination with the image header located in the local data ram contains the following information:

- Boot software version
- Internal Instruction and Data RAM test status
- ASW loaded and integrity status
- Start of execution (entry point)

# LEON3FT Microcontroller

- Application software id

The total size of the boot report allocated in the data memory is 8 bytes. The boot address always allocates the last 2 words in the local data memory. The boot report format:

Table 661. 0x30000FF8 - BOOTRPT0 - Boot Rom Report

31		10	9		7	6	5	4		2	1	0
	Reserved				CPY	EXT	RMT			I	D	
	0				*	*	*			*	*	
	rw				rw	rw	rw			rw	rw	

- 31: 10    Reserved.
- 9: 7    ASW source copy (CPY) - Status field for ASW source selected:
  - 0x0 - None
  - 0x1 - SRAM chip select 0 and 1
  - 0x2 - PROM chip select 0 and 1
  - 0x3 - SPI memory using dedicated external SPI memory interface
  - 0x4 - SPI redundant memory interface
- 6: 5    External boot source (EXT) - Status field for external boot source:
  - 0x0 - None
  - 0x1 - External SRAM/MRAM using SRAM chip select 0
  - 0x2 - External PROM using PROM chip select 0
  - 0x3 - External SPI memory
- 4: 2    Remote access (RMT) - Status field for remote access:
  - 0x0 - None
  - 0x1 - SpaceWire remote access enabled
  - 0x2 - UART remote access enabled
  - 0x3 - CAN-FD
  - 0x4 - SPI remote access enabled
- 1    Onchip instruction memory test (I) - 1: memory failure detected,, 0: test passed.
- 0    Onchip data memory test (D) - 1: memory failure detected,, 0: test passed.

Table 662. 0x30000FFC - BOOTRPT1 - Boot Rom Report

31		0
	Reserved	
	0	
	rw	

- 31: 0    Reserved

In case of using the ASW container the application can read and check the latest ASW header located in the data memory on address specified in table 658 and ASW header format in table 663.

## 51.2.6 Application software image format

Application software image files are located in ASM from where they are loaded by the Boot software Application loader. An image consists of an image header, a number of image section headers, and a variable number of data blocks. All addresses (entry point and data destination addresses) must be aligned to 32-bit words. The sections are of two types: data sections and WMEM sections. A WMEM section provides a simple way to perform additional system initializations before

# LEON3FT Microcontroller

handing over the system to application software. The format of the regular ASW and WMEM sections are described in Table 665 and Table 666 .

Table 663. Image header

Field	Type	Description
id	32-bit word	User defined section. The values does not affect Boot software execution.
ep	32-bit word	Application software entry point
stp	32-bit word	Application stack pointer
sections 0	image section header	Section layout defined in table below.
sections [1 ..15]	image section header	Section layout defined in table below.
cksum	16 -bit word	16-bit ISO checksum as defined in [ECSS-E7041], annex A. Calculated over all fields of the image header.
Reserved	16-bit word	Reserved, set to zero

Table 664. Image section header

Field	Type	Description
flags	32-bit word	Bit 0: ENABLE - This section shall be copied to RAM. Bit 1: RESERVED- Must be 0 Bit 2: WMEM : 0 -> This section is a regular section 1 -> This section is a WMEM section Bit 31..3: RESERVED - Must be 0
source	32-bit word	Location of source data block, expressed as number of 32-bit words relative to image header. (Note: Offset is not relative to section header.)
dest	32-bit word	Absolute destination address (As this filed is not used by WMEM sections, it can be set to 0 for WMEM headers)
length	32-bit word	Length of section data block in 32-bit words.
datacksum	16-bit word	Data block checksum over data[0]..data[length-1]. 16-bit ISO checksum as defined in [ECSS-E7041], annex A.
Reserved	16-bit word	Reserved

Table 665. Image data block for a regular section

Field	Type	Description
data[0]	32-bit word	Data word 0
data[1]	32-bit word	Data word 1
...	...	...
data[length-1]	32-bit word	Data word length-1



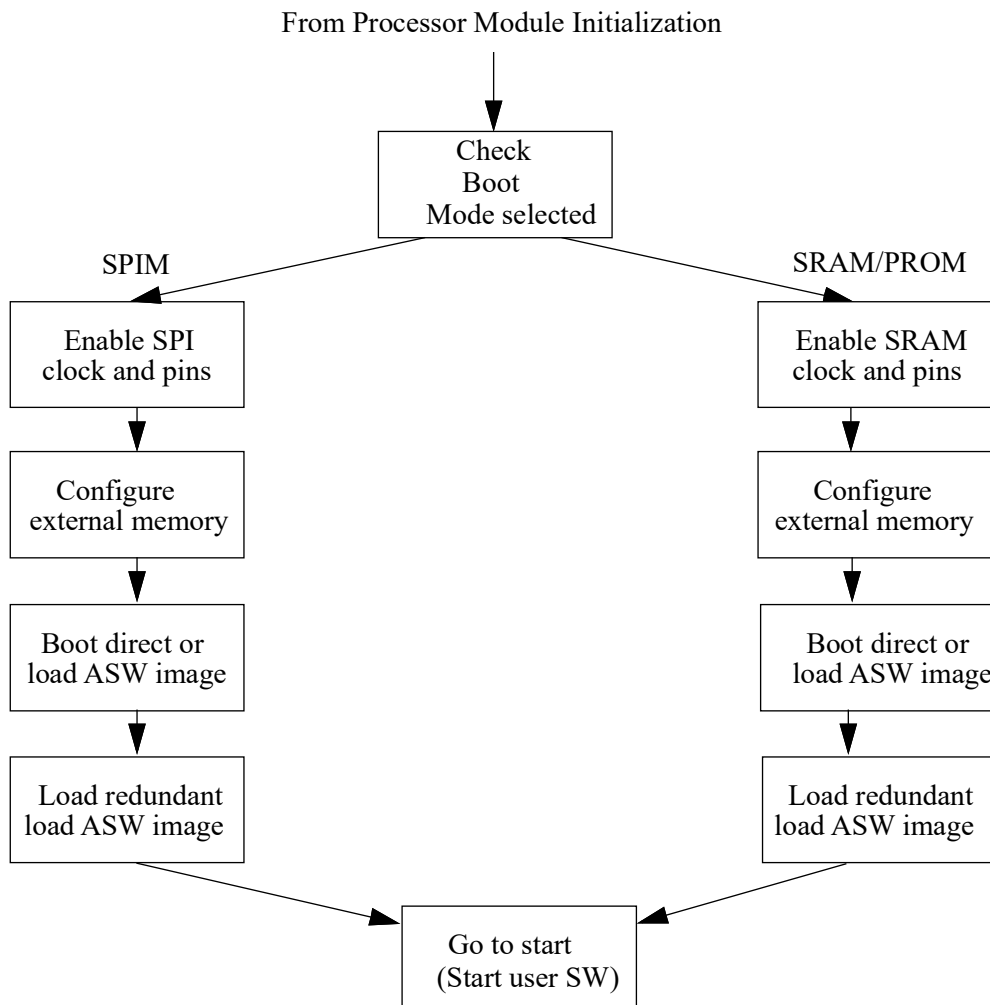
Table 666. Image data block for a WMEM section

Field	Type	Description
Address[0]	32-bit word	First address to be written
data[0]	32-bit word	Data word to be written at address[0]
Address[1]	32-bit word	Second address to be written
data[1]	32-bit word	Data word to be written at address[1]
...	...	...
data[length-1]	32-bit word	Data word length-1

When the application software is loaded the image header read is always stored in top of memory. The application software can determine its origin by reading the stored header in the local data memory. The image header start is always set to 'boot\_image\_header' from the end of the last address in the local data memory.

### 51.3 Loader description

Load sequence is the summing-up of Boot software components executing after standby mode. The component includes enable clocks and pins, image loading and application software boot.



*Figure 103. Load sequence detailed description*

For more information see Table 658.

## 51.4 Standby description

After processor initialization has completed the Standby mode is started if selected by the bootstrap signals. The bootstrap configures which interface is used for the remote control. For each of the remote access options the boot software enable interface clock and pins. See sections below for more information about which pins are used for respective interface.

Full access is granted to the unit accessing the GR716B Microcontroller via the selected remote control and access interface. When remote control unit upload new software to the GR716B Microcontroller the remote unit can reset and re-start the processor via the interrupt controller unit, see chapter 40 for more information. The remote unit needs to instruct the GR716B Microcontroller to restart and start executing the uploaded software.

While in standby mode the processor is in power-down mode. The watchdog timer is activated during Standby mode.

### 51.4.1 CANFD (CANOpen)

A remote host can access the AHB DMA bus via the CAN interface described in chapter 26.

Information on which pins used to connect to the external CAN bus is described in Table 21.

### 51.4.2 SpaceWire - RMAP

A remote host can access the AHB DMA bus via the SpaceWire RMAP interface described in chapter 33.

Information on which pins used to connect to the external SpaceWire bus is described in Table 21.

### 51.4.3 SPI2AHB

A remote host can access the AHB DMA bus via the SPI2AHB interface described in chapter 43.

Information on which pins used to connect to the external SPI bus is described in Table 21.

### 51.4.4 UART

There are two AHBUART interfaces on the GR716, only the AHBUART connected directly to the AHB DMA bus is used for the remote control in Standby mode.

A remote host can access the AHB DMA bus via the AHBUART interface described in chapter 48.

Information on which pins used to connect to the external UART bus is described in Table 21.

## 51.5 State at handover to application software

After the boot sequence has finished the following general state applies:

- GPTIMER prescaler is set to `gptimer_prescaler`
- Watchdog timer value is set to `wdg_timeout_app` or `wdg_timeout_reomte` and is kicked in less than 100 clock cycles from entry to ASW.
- Boot report is located at address `boot_report`
- ASW header is located at the address `boot_image_header`.
- All interfaces are disabled except for the interface requested to be enabled via bootstraps
- The clock-gate unit is configured according to the bootstrap configuration

# LEON3FT Microcontroller

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- Frame pointer (register %fp) is set to the start before the boot report
- Stack pointer (register %sp) is set to frame pointer minus 96.
- PSR.S=1, PSR.ET=0, PSR.CWP=0, PSR.EF=0
- WIM=0x2
- Single vector trapping is disabled

For more information see Table 658.

# LEON3FT Microcontroller

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## 51.6 Boot source requirements (TBD)

This chapter specifies limitations to external interface or components during boot.

### 51.6.1 SpaceWire Remote access

Remote access via SpaceWire (without software support) requires the SpaceWire input frequency to be 5 MHz, 10 MHz, 20 MHz or 25 MHz.

### 51.6.2 External SPI Memory

External SPI memories will be clocked with system clock divided by 8 during the boot sequence. The external SPI memory is assumed to support read command 0x3 and have 3 or 4 address bytes as default.

### 51.6.3 External PROM/SRAM memory

The access time for external PROM shall be equal or less than 16 system clock cycles and for external SRAM the access time shall be equal or less than 4 system clock cycles.

### 51.6.4 NVRAM

Booting using the NVRAM memory controller is also supported by the ASIC design, please contact [support@gaisler.com](mailto:support@gaisler.com) for more information about options for bare die.

## 51.7 Protection schemes

The boot image has a number of protection schemes build in to check for erroneous boot software, hardware malfunction:

SRAM/PROM:

- BCH EDAC protection
- Scrubber (SRAM only)
- ASW load image protection with CRC protection
- Redundant ASW load image
- Watchdog timer

SPI Memory:

- BCH EDAC protection
- ASW load image protection
- Redundant ASW load image with CRC protection
- Watchdog timer

Remote Access:

- Watchdog timer

Internal Memories startup test (Instruction, Data and Register Window):

- Scrubber (Instruction and Data)
- Memory test at startup.

Boot ROM startup and access:

- Protection of unwanted access or start of boot due to erroneous trap handler
- Watchdog timer

# LEON3FT Microcontroller

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## 51.7.1 BCH EDAC Protection

When the memory controller with EDAC enabled (SPIMCTRL/FTMCTRL) detects a correctable error, the data will be temporarily corrected and delivered onto the on-chip bus.

A uncorrectable error detected during a load of a ASW will force the boot ROM software to enter error state and wait for re-boot or try to load a redundant ASW image.

## 51.7.2 Hardware Scrubber

The scrubber is used by the Boot ROM to clear internal instruction and data ram.

## 51.7.3 ASW load image

Application software load image correctness can be checked using 16-bit cyclic redundant code defined in [ECSS-E7041]. The load image also provides features to automatically copy instruction and data sections before executing ASW.

## 51.7.4 Redundant ASW load image

All externally memory boot options have the capability to boot from redundant memory in case of bad CRC is detected on first boot image. An error on the second will force the GR716 microcontroller to reboot and retry the first image.

PROM primary boot uses external ROM chip select signal 0 and redundant PROM uses ROM chip signal 1.

SRAM primary boot uses external ram chip select signal 0 and redundant SRAM uses RAM chip signal 1.

SPI memory boot automatically selects SPI memory controller 0 as primary boot and SPI memory controller 1 as redundant boot option.

## 51.7.5 Watchdog Timer

A watchdog timer will be enabled to detect erroneous behavior during boot sequence. The Watchdog Timer is reloaded at reset and during start of the boot ROM and at the end of boot ROM to make sure the ASW or accesses from the external interface can be executed or received.

The watchdog have different settings and reload value depending boot software executed and boot option selected by user.

Watchdog timeout value and state:

- During initialization of boot software and memory test the watchdog is set to a value '*wdg\_timeout\_boot*' long enough to cope with memory and register test. The watchdog is always enabled at boot program start because the boot software might have been called from an unwanted trap.
- For application booting from external memory the watchdog is set to a value '*wdg\_timeout\_app*' long enough to cope with starting or loading an application from an external memory.
- For application booting via remote access the watchdog is set to a value '*wdg\_timeout\_remote*'. The value is set to a 'extrem' long value to be able to cope with slow transfers or interfaces. The watchdog timer reload register is accessible via remote interface and in case where software upload is extremely slow the remote software should be able to extend or reload the watchdog counter by writing to the watchdog timers registers.
- When a failure is encountered during initialization of the microcontroller which can't be resolved the boot software requests a system reboot by setting the watchdog timer to a '*wdg\_timeout\_restart*'.

### 51.7.6 Memory test

The memory test write a predefined pattern consecutively to the whole memory. It reads the data back and verifies for equality. The same procedure is repeated with an inverted pattern. This tests the integrity of the memory device it self i.e. test that every bit in the memory is capable of holding both 0 and 1.

In case memory test passes, the memory area is cleared. In case of failure a flag will be raised in the boot report.

# LEON3FT Microcontroller

## 52 Real-Time Accelerator (RTA)

### 52.1 Overview

This chapter describes the Real-Time-Accelerator (RTA) block integrated in to GR716B

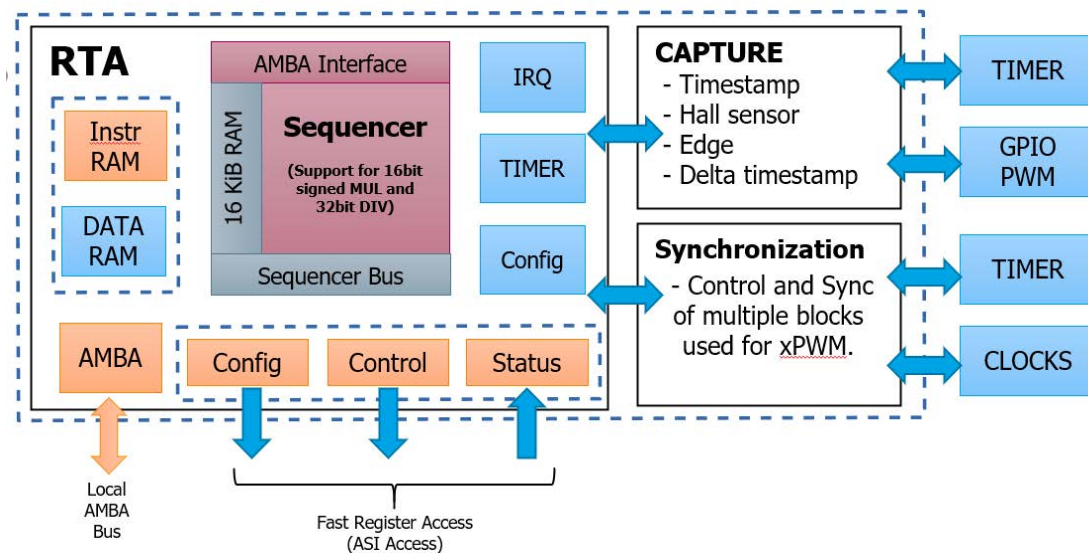


Figure 104. Simplified architecture and functional block diagram of the RTA and connections

The Real-Time-Accelerator (RTA) includes:

- LEON3FT processor core with 2 register windows and support for 32-bit multiplier and accumulator. Support for floating point unit is not foreseen.
- Separate system timer possible to synchronize to system timer
- IRQMP local interrupt controller with start/stop/reset control
- RTA Task Manager (RTA) and interrupt time stamp functionality
- AHB/AHB bridge with access to control to separate the RTA system from the mainGR716B system
- AHB bridge with access to following to peripherals

The RTA module is an independent LEON3FT subsystem and can execute software in parallel with the main LEON3FT processor in GR716B. The RTA subsystem can access 16KiB of tightly coupled memory protected by EDAC to ensure single cycle instruction execution. The RTA implements 2 sets of registers window and support interrupts.

The RTA shares the address map with the main LEON3FT processor in section 2.10. The RTA needs to access granted via control registers to get access to the main bus. See system configuration register in section 7.3. The system configuration register can also grant access to on-chip memory for single clock cycle software execution.

Each RTA have separately clock and reset control possibility. See section 28.

The software execution is started and controlled via the local interrupt controller. See section 40.2.7 on dynamically controlling software execution.

### 52.2 Operation (TBD)

TBD

# LEON3FT Microcontroller

## 52.3 RTA Status and mailbox Register

RTA status and mailbox register for simple inter-task communication from the RTA to the main LEON3FT processor.

Any status bit(s) in the register RTAx.STAT can generate an interrupt to the main processor. Application needs to set the corresponding level and enable bit in the registers RTAx.STAT.LVL and RTAx.STAT.MASK.

Table 667. RTA status and mailbox register base addresses (TBD)

AMBA address	Register	Acronym
0x62040000 0x72040000	RTAx status and mailbox status register	RTA0.STAT.REG RTA1.STAT.REG
0x62040004 0x72040004	RTAx status and mailbox interrupt level detection configuration register	RTA0.STAT.LVL RTA1.STAT.LVL
0x62040008 0x72040008	RTAx status and mailbox interrupt register	RTA0.STAT.IRQ RTA1.STAT.IRQ
0x6204000C 0x7204000C	RTAx status and mailbox mask register for interrupt generation	RTA0.STAT.MASK RTA1.STAT.MASK

Table 668. 0x62040000 / 0x72040000 - RTAx.STAT - RTA status and mailbox register status register

31	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0				
USR	LW	LI	LR	R														DM	DE	FC	IC	BP	DU	SU	IP	ID	PW	HA	ER				
0x0	0x0	0x0	0x0	0x0														0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	
rw	r	r	r	r														r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r

- 31: 28 User defined status bits (USR)
- 27 Local RTAx Watch Dog Timer Alarm (LW) - Local watchdog has triggered and generated local interrupt
- 26 Local Interrupt Alarm (LI) - A local interrupt have occurred.
- 25 Local RTAx interrupt resume Alarm (LR) - Processor has been resumed
- 24: 11 Reserved
- 11 DSU mode (DM)
- 10 DSU Enable (DE)
- 9 Fault Counter (FC)
- 8 Instruction Counter (IC)
- 7 BP missed (BP)
- 6 DU Counter (DU)
- 5 SU state (SU)
- 4 Interrupt pending (IP)
- 3 Power down state (PD)
- 2 IDLE state (ID)
- 1 Halt (HA)
- 0 Error (ER)

Note When corresponding bit are set in the RTAx.STAT.LVL and RTAx.STAT.MASK register an interrupt will be generated

Table 669. 0x62040004 / 0x72040004 - RTAx status and mailbox interrupt level detection configuration register

31	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
USR	LW	LI	LR	R														DM	DE	FC	IC	BP	DU	SU	IP	ID	PW	HA	ER



Table 669. 0x62040004 / 0x72040004 - RTAx status and mailbox interrupt level detection configuration register

0x0	0x0	0x0	0x0	0x0											0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	
rw	rw	rw	rw	r											rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

Table 670. 0x62040008 / 0x72040008 - RTAx status and mailbox interrupt register

31	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
USR	LW	LI	LR	R											DM	DE	FC	IC	BP	DU	SU	IP	ID	PW	HA	ER						
0x0	0x0	0x0	0x0	0x0											0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	
wc	wc	wc	wc	r											wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc	wc

Table 671. 0x6204000C / 0x7204000C - RTAx status and mailbox mask register for interrupt generation

31	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
USR	LW	LI	LR	R											DM	DE	FC	IC	BP	DU	SU	IP	ID	PW	HA	ER						
0x0	0x0	0x0	0x0	0x0											0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	0x0	
rw	rw	rw	rw	r											rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw

### 52.3.1 RTA Task Manager (RTM) and interrupt time stamp functionality

A central block for real-time RTA execution is the RTA Task Manager (RTM). It can be viewed as a user-configurable link between hardware real-time events, from peripherals such as analog PWM functions, and start of RTA task routines. Task priority is also handled in the RTM.

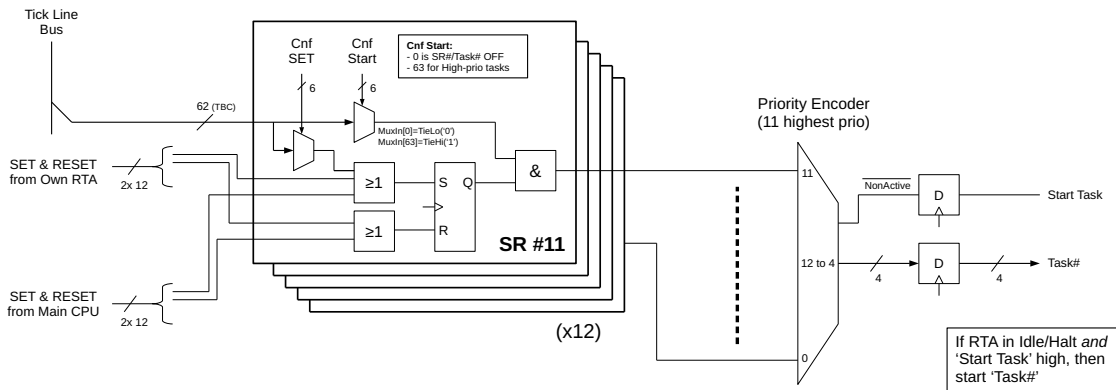


Figure 105. Simplified schematic view of RTA Task Manager and interrupt time stamping

Interrupt handling in a deeply pipelined architecture, such as LEON3FT, would require unnecessarily long time for storing and re-storing all states in the pipeline structure and other registers to and from the stack. When handling applications like DC/DC controllers, it is critical that the starts and stops of the software execution are very short and efficient. Therefore, the RTA Task Manager (RTM) only executes code in the LEON3 in 'one execution level', without needing conventional interrupt handling. Before starting the next task, it requires the LEON3 to be in Idle/Halt state

RTM also allows the system to support strict time schedule software execution and asynchronous system tasks, based upon system events or interrupts according to the following conditions:

# LEON3FT Microcontroller

- High-prio task, with the highest Encoder Priority, starts immediately when: the configured event or interrupt is activated and the RTA is in Idle/Halt state.
- Low-prio task, does not start until the configured event or interrupt activates at the same time as the RTA is in Idle/Halt state. The definition of a Low-prio task function can effectively be viewed as a 'time gating' when the Low-prio task is allowed to start.

Each RTA subsystem has 3 separate RTM systems named RTM0, RTM1 and RTM2. Each individual RTM system can be configured to use up to 12 tasks.

Table 672. RTM0, RTM1 and RTM2 status and configuration register (TBD)

AMBA address	Register	Acronym
0x62060000	RTM Status register	
0x62060004	RTM Interrupt register	
0x62060008	RTM Mask register	
0x6206000C	RTM Interrupt Level trigger register	
0x62060010	RTM Task 0 Configuration	
0x62060014	RTM Task 1 Configuration	
0x62060018	RTM Task 2 Configuration	
0x6206001C	RTM Task 3 Configuration	
0x62060020	RTM Task 4 Configuration	
0x62060024	RTM Task 5 Configuration	
0x62060028	RTM Task 6 Configuration	
0x6206002C	RTM Task 7 Configuration	
0x62060030	RTM Task 8 Configuration	
0x62060034	RTM Task 9 Configuration	
0x62060038	RTM Task 10 Configuration	
0x6206003C	RTM Task 11 Configuration	
0x62060040	RTM Task Low Priority Configuration	
0x62060044	RTM Task High Priority Configuration	
0x62060048	RTM Task Set Configuration	
0x6206004C	RTM Task Clear Configuration	
0x62060080	Current Active Task Number Selected	
0x62060084	Next Waiting Task Number	

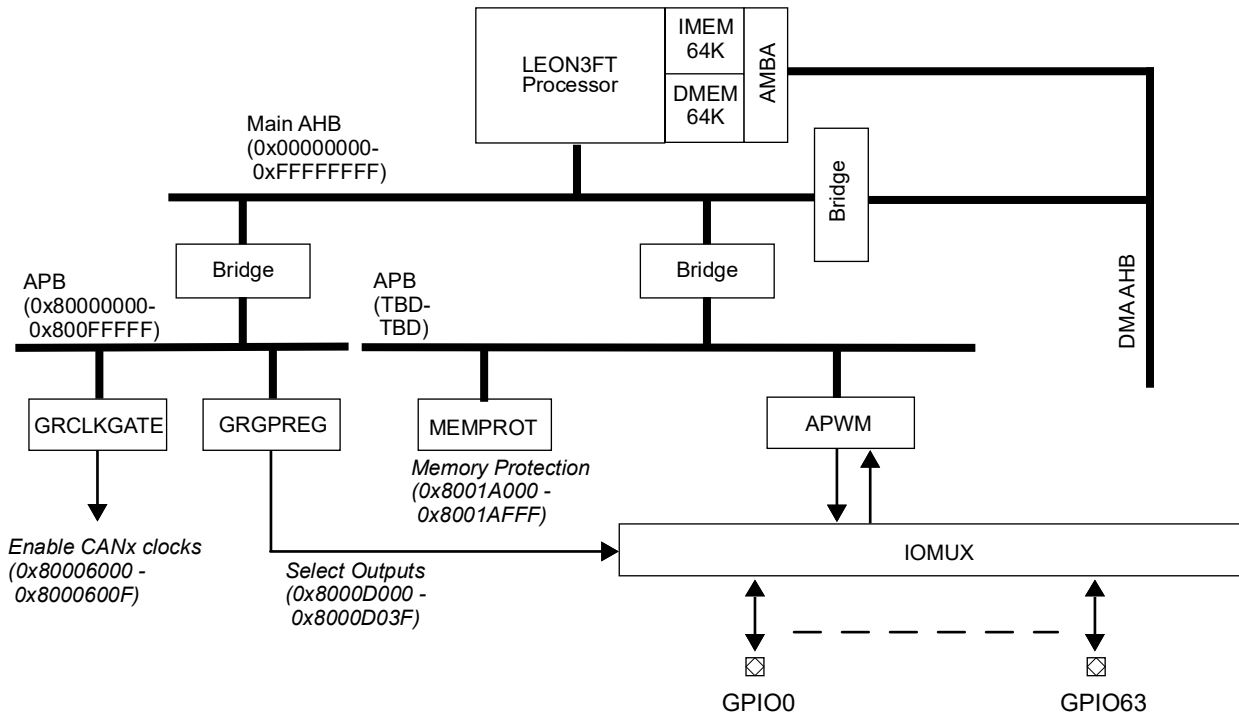
Note 1: All RTM systems or blocks has the same configuration and status registers

## 53 Analog Applications Pulse Width Modulation (APWM)

The GR716B microcontroller contains an Analog applications PWM (APWM) unit, which contains several different types of PWM functions. The main purpose of the APWM unit is to support DC/DC and motor control applications and it can be used in many other application areas.

The APWM controller unit controls its own external pins and has a unique AMBA address described in section 2.10. The APWM unit is located on APB bus in the address range from **TBD to TBD**. See APWM unit connections in figure 106. It shows memory locations and functions used for APWM configuration and control.

Figure 106. GR716B APWM bus and pin connection



The secondary clock gating unit **GRCLKGATE** described in chapter 28 is used to enable/disable the APWM units. The unit **GRCLKGATE** can also be used to perform reset of the APWM unit. Software must enable clock and release reset described in chapter 28 before APWM configuration and transmission can start.

External IO selection per APWM unit is made in the system IO configuration register (**GRGPREG**) in the address range from 0x8000D000 to 0x8000D03F. See chapter 28 for further information.

The **APWM** unit control its own external pins and has a unique AMBA address described in section 2.10. The APWM configuration and status registers are described in section 53.8

System can be configured to protect and restrict access to individual APWM units in the **MEMPROT** unit. See chapter 47 for more information.

# LEON3FT Microcontroller

## 53.1 Overview of APWM unit

To support the area of switching power supply (DC/DC) and motor control applications, a set of pulse width modulator (PWM) hardware blocks have been implemented in GR716B, see figure 107 and sections 2.2.12 and 2.2.13.

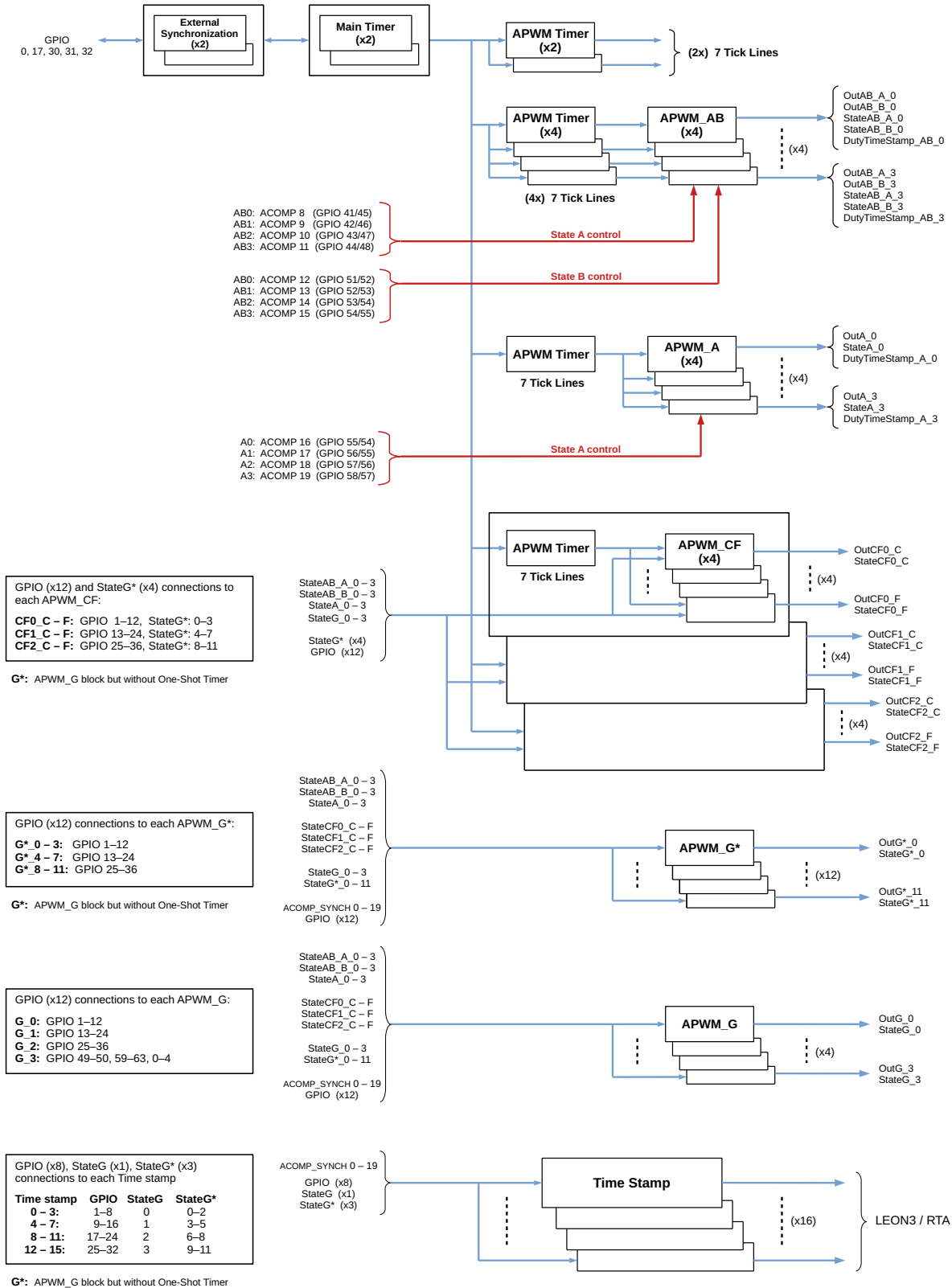


Figure 107. Overview of APWM hardware functions. All APWM output blocks to the right can be real-time synchronized to each other, and the Main Timers at the top can be externally synchronized to or from external circuitry, e.g., another GR716B device.

# LEON3FT Microcontroller

For DC/DC control applications, the APWM hardware blocks provide support for:

- 4 independent DC/DC controllers in peak-current control mode (APWM\_AB), and more controllers in voltage or frequency control mode (APWM\_A/AB/CF).
- Overcurrent detection and protection shutdown (ACOMP and Alarm Matrix).
- Max duty-cycle limiting.
- Power switch turn-on delay, configurable cycle-by-cycle from RTA.
- Leading edge blanking (LEB), configurable cycle-by-cycle from RTA.
- Extended PWM outputs (APWM\_CF and APWM\_G), supporting various full-bridge DC/DC converter topologies.

For motor control applications, the APWM hardware blocks provide support for:

- 4 BLDC or PMSM motors or 6 micro stepper motors, in PWM control mode (APWM\_CF), and more motors in immediate GPIO control mode.
- 4 analog channels with simultaneous ADC sampling to facilitate motor control.

The number of supported controllers can be combined as different number of DC/DC controllers and motor controllers. And in the case where only APWM\_AB blocks (x4) are used for 4 basic DC/DC converters (e.g., buck, boost, flyback), the APWM\_CF blocks (x12) can be used to support 4 motors.

The APWM\_AB block is designed to generate two gate-driver signals suitable to control the two power switches in a half-bridge switch constellation. The APWM\_A block is a simplified version of APWM\_AB. It has only one output and can be used in application areas such as low-power supply converters, and current or voltage signal sources. When motor PWM control is to be implemented, the APWM\_CF blocks can be used to control half-bridges for standard BLDC and PMSM motors. Each APWM\_CF is a general PWM block configurable to work stand alone or as an extension of APWM\_A /AB. The APWM\_G block, working as extension on the other APWM blocks, supports control of various complex DC/DC converter topologies, including full-bridge converters with synchronous rectification such as phase-shifted full bridge.

Each APWM Timer (24bit) in figure 107 can be configured to its own period cycle, and to its own start time point in a Main Timer cycle (32bit). When running more than one DC/DC converter, it can be of interest to run all power converters on integer multiples of each others' switching frequencies. Otherwise, there may be a significant risk of EMC problems from undesired intermediate frequencies, i.e., the difference(s) between switching frequencies appearing as low-frequency disturbance(s), which can be tricky to find and solve in switching power systems in general. The configurability of these timers allows for programming of any desired integer-multiple of frequencies and relative time positions of power-cycle starts for each DC/DC controller individually.

Each timer can generate real-time tick/trigger signals, which can be configured to start RTA task routines, ADC conversions, DAC writings, etc. A real-time tick/trig can be set to any time position in the cycle of the timer, and it will be cycle-repeatable and deterministic on system clock cycle-by-cycle level.

## 53.2 APWM\_AB description

The APWM\_AB hardware block is designed to generate two gate-control signals, Out A and Out B in figure 108, suitable to control the two power switches in a half-bridge switch constellation. The duty cycle can be controlled from peak-current analog comparator, ACOMP State A, or from RTA. Also the frequency from APWM Timer can be reprogrammed PWM cycle-by-cycle from RTA. Hence, all DC/DC topologies, which run in current or voltage control mode with variable duty cycle or frequency, are supported.

# LEON3FT Microcontroller

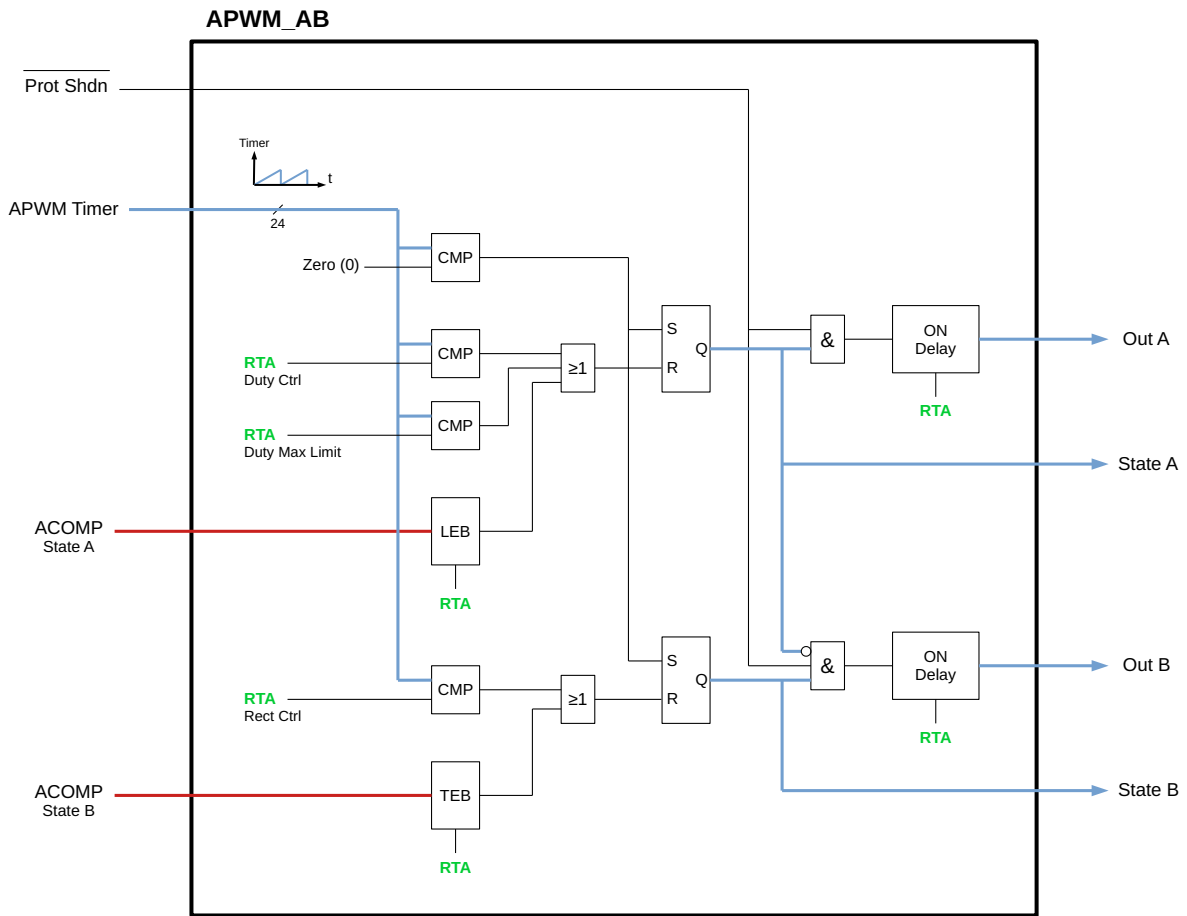


Figure 108. Functional diagram of APWM\_AB

## 53.2.1 Operation

A half-bridge switch constellation is used in many switching power-converter topologies such as in step-up (boost) converters and step-down (buck) converters. The latter will be used as application example in the detailed presentation of the APWM\_AB operation here, see figure 109. More examples of APWM\_AB application connection diagrams for commonly used DC/DC topologies are presented in section 53.19.1.

# LEON3FT Microcontroller

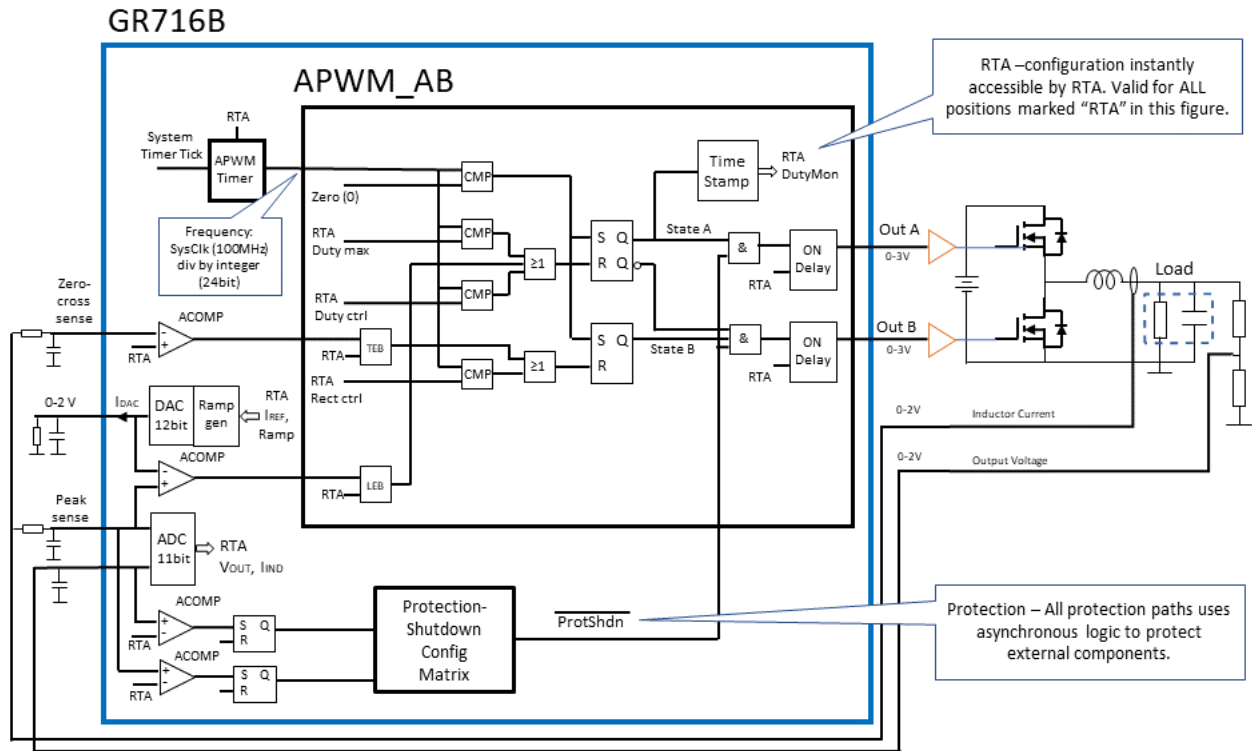


Figure 109. Simplified application schematic of a step-down (buck) converter controlled by APWM\_AB.

The Out A signal is connected to the active ON duty-cycle switch, which connects the inductor to the input power bus, and thereby increases the inductor current, i.e., increases its stored energy. The second switch is used for synchronous rectification during the switch-cycle OFF time, when the stored inductor energy is discharging into the large output capacitor. In cases where the second switch is implemented, it is connected to the Out B signal. This switch can be replaced by a diode when power efficiency is of less importance. The main benefit of using the second switch is that it provides lower power dissipation compared to a diode, thereby improving the power efficiency of the converter. For applications in the order of 10 A and higher output current, this switch is normally beneficial to implement, but for the order of 1 A and lower it is less space and cost efficient compared to the benefits.

The ON Delay block provides programmable dead-time between switching of the two power switches, which is reprogrammable PWM cycle-by-cycle from RTA. The main use case is usually to ensure enough time margin for skew between the two PCB gate drivers for Out A and B, where a dead-time in OFF state must be guaranteed at the two power MOSFET gates. Another use case can be to continuously maintain maximum power efficiency under all operating conditions, e.g., change of switch timing characteristics over temperature, load current, etc. Also various switching schemes based on optimum zero-voltage switching are supported by continuous control of the ON Delay block.

The duty-cycle regulation is based on peak-current control. The current-sense signal goes into the on-chip analog comparator, ACOMP for State A, which has the reference level set by an RTA-programmable DAC output. The DAC provides a sourcing-current output, where the user should put a resistor to ground on PCB to give the resulting DAC-output voltage. The DAC also has built-in RTA-programmable digital ramp generation.

The current-sense signal goes into an ADC input, in parallel with the ACOMP input, so it can be measured for monitoring purposes and made available to the RTA for control-law calculations, etc. When ADC measurement is to be done, the ADC track turn-on event can disturb the GPIO pin, see 12.2.8 to

## LEON3FT Microcontroller

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12.2.9. Therefore, in the case current measurement should be done as early as possible in the duty-cycle period, the track turn-on time point is preferably configured at the power-switch turn-on point.

The following leading-edge blanking (LEB) time should be configured long enough to cover the ADC track transient and the switching of the power switches, which may be in the range 0.1-0.5  $\mu$ s. The track time should be long enough to ensure accurate settling of the ADC S/H capacitor, which is 0.3-0.7  $\mu$ s after LEB ends, depending on settling during LEB time and required accuracy. In the case current measurement should be done in the middle of the duty-switch on time, where the inductor current is approximately the average of the on-time current, the Tick time point for ADC start needs to be continuously updated with the right track start point. Moreover, ADC S/H capacitor precharge to ground should be considered, see 12.2.8.

The regulation of the converter output voltage is typically performed by first taking an ADC sample of the output voltage. The RTA executes the control-law calculations based on this output-voltage sample and any earlier samples. This results in a new current-reference level written to the DAC before the analog comparator will reach its peak-current trig level in the upcoming power switching cycle. Note that this trig level will have no effect until the leading edge blanking (LEB) time has past, so it is essential to configure LEB correctly. This whole ADC-RTA-DAC sequence is continuously repeated once per power-switching cycle, which provides continuous regulation of the output voltage.

Duty-cycle regulation can, instead of peak-current control, be performed directly from the RTA by using 'Duty Ctrl' in figure 109. This is the case when voltage-mode control is to be implemented instead of peak-current control. Moreover, in special transient situations, running in peak-current mode, it may be handy to be able to control (limit) the duty cycle temporarily, to handle transient peaks by non-linear regulation possible to implement only digitally in RTA software.

In addition to the above duty-cycle control methods, there is also a maximum duty-cycle limit that can be configured, see 'Duty Max Limit'. It can be useful in converter implementations that require a guaranteed minimum OFF time per switch cycle, e.g., to re-charge a bootstrapped highside gate-driver supply. Moreover, some converter topologies, e.g., step-up (boost) converters, must be prohibited from running all the way up to 100% duty cycle, to avoid power-switch stress or damage from regulation-transient overcurrents.

When synchronous rectification is used, it can be configured to run continuously (Out B inverse of Out A); or, diode emulation can be used when back-feeding of power onto the input power bus should be avoided. In diode-emulation mode, either 'Rect Ctrl' by RTA or Zero-crossing sense by ACOMP can be used to turn off the rectification switch (Out B), which should happen at the current zero-crossing point. When 'Rect Ctrl' is used, a new value can be written PWM cycle-by-cycle from RTA. When zero-crossing sense by ACOMP is used, it is essential to handle current-sense parasitics on PCB carefully and configure trailing edge blanking (TEB) time correctly.

Protection functions in hardware are provided in the form of overvoltage and overcurrent analog comparators, see the two ACOMPs connected to SR-latches in figure 109. They are connected to the central Alarm and Shutdown Matrix in GR716B. Here, any protection alarm signals from DC/DC converters, or other critical related functions on the chip or PCB design, can be configured to shut down one or more DC/DC converters and other related functions, to ensure safe and simultaneous shut down of each whole application. In this ACOMP use case, the disturbance tolerant (SET hard) configuration mode can be recommended, to avoid unnecessary faulty shutdowns of applications.

Note that these protection ACOMPs re-use the same sense package pins as the regulation sense pins, so they cannot protect against hardware failure inside the power converter itself, e.g., pin failure on GR716B. Hence, these ACOMPs can typically be regarded as protection against excessive load current caused by temporary load failures, or against abnormal input voltage, e.g., caused by fuse blows on power system level. They can also protect against faulty or unexpected behavior of the control-law software in RTA. In cases where additional protection would be required, e.g., protection against hardware failures inside the power converter itself, independent hardware will have to monitor the converter, and safely shut it down with an independent set of power switches other than the two power



# LEON3FT Microcontroller

switches discussed in this application example. This independent hardware, including the independent set of power switches, need to be supplied by independent auxiliary supply on power system level.

## 53.2.2 Registers

TBD

## 53.3 APWM\_A description

The APWM\_A block is a simplified version of APWM\_AB, and has only one PWM output, see figure 110. It can be used in application areas such as low-power DC/DC converters, and current or voltage sources at medium-power signal level, in general for maximum output power in the range 0.01 to 10 W. For low-power DC/DC converters, the APWM\_A and its ACOMP run in peak-voltage mode without RTA, ADC and DAC. It gives an added GR716B consumption per controller of about 1mA from 1.8V supply, and about 0.5mA from 3.3V supply, which should be negligible compared to any other losses in the converter. Instead of alternative solutions such as non-SET-hard radiation-tolerant LDO ICs, these SET-hard APWM\_A based converters can provide robust solutions for low-power DC/DC converters. An example of application area is to generate the auxiliary supply voltages to FPGAs, where the need of supply current is low.

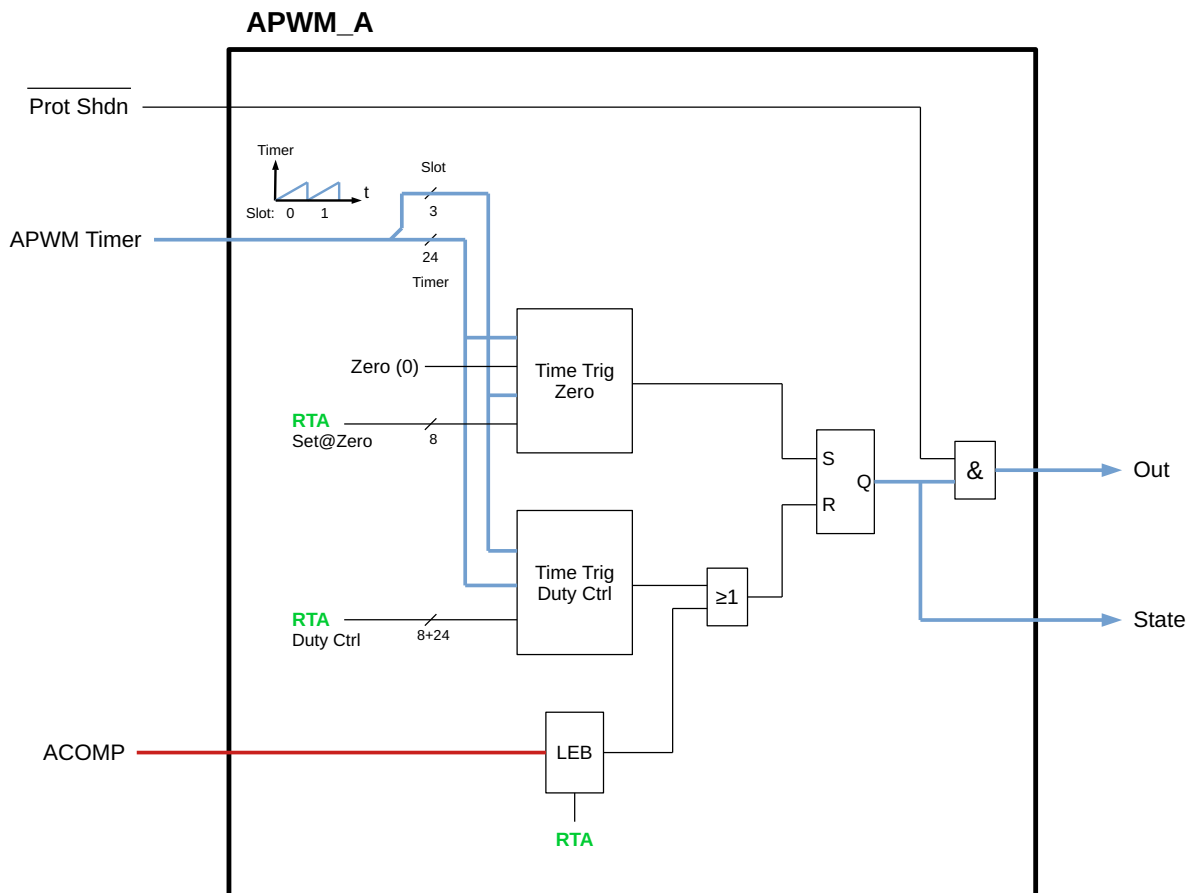


Figure 110. Functional diagram of APWM\_A

# LEON3FT Microcontroller

A feature for APWM\_A, together with its APWM Timer, is that they can be configured to work in up to 8 time slots, see the 3bit Slot count in figure 110. APWM Timer Slot configuration equal to 7 gives Slot count from 0 up to 7 and restart from 0 again. Configuration equal to 1 gives Slot count from 0 to 1 and restart from 0. Configuration equal to 0 gives Slot count equal to 0 continuously.

The APWM\_A blocks have a common APWM Timer and can easily be configured to work in a certain time-slot sequence, where some APWM\_A can work in sequence, some simultaneously, and some can use more than one time slot, etc. Furthermore, when multiple APWM\_CF blocks are combined with one APWM\_A block, each APWM\_CF can control an individually regulated supply voltage. Thus, one common ACOMP, through its APWM\_A, can be used to regulate a unique supply output voltage in each time slot of up to 8 slots, using up to 8 APWM\_CF blocks. Examples of low-power DC/DC converters are presented in section 53.19.2 and 53.19.3.

The examples are focused on low-power DC/DC converters, but any time-varying medium-power signal voltage or current can be regulated by APWM\_A. A benefit of using APWM\_A instead of APWM\_DAC, see section 54, is the well controlled (higher) power efficiency. The reason is that the number of switchings per second are exactly controlled by the APWM Timer, whereas for APWM\_DAC, switchings per second can vary a lot and become very many. In medium-power applications this could give a disastrous drop of efficiency due to uncontrolled and high switching losses, and possibly even cause permanent damage to the power-switch devices due to overheating.

A drawback with APWM\_A control is that there will be a significantly higher output switching ripple at the switching frequency. Therefore, a low-pass filter with significantly lower cut-off frequency is needed, which will give significantly lower signal bandwidth in APWM\_A than APWM\_DAC designs. However, when APWM\_A is used to generate signal output voltage or current, there may not be any strict requirement on peak overshoots in the same way as there are peak requirements for DC/DC converter outputs. Therefore, a network of various resistors, inductors and capacitors could be used in these APWM\_A designs to obtain improved output ripple, bandwidth, etc, which will reduce the bandwidth drawback of APWM\_A. Anyhow, it will depend on the specific application what type of PWM solution that is best in each application case.

## 53.3.1 Operation

When the analog comparator, ACOMP, is used to control (turn off) the duty cycle in a DC/DC converter, it will typically be configured to trig on a fixed output voltage level. Each PWM cycle, it turns off the duty-cycle switch instantly when the configured reference voltage level is reached, which effectively becomes a peak-voltage mode controller. Another way to control (turn off) the duty cycle is to use the 'Duty Ctrl' register in APWM\_A, which can be updated PWM cycle-by-cycle from RTA. In this case, the application output signal needs to be measured by ADC, the RTA calculates the required duty cycle, which is written to the 'Duty Ctrl' register. In the following descriptions of APWM\_A, control by the 'Duty Ctrl' register is regarded a complementary feature to be implemented if desired, and the main control will be implemented by ACOMP peak control. An essential reason for this control choice, when using APWM\_A, is to off-load the RTAs and ADCs to free their capacity for other applications.

In cases where ADC measurements are needed on the same GPIO pin as ACOMP is used, the ADC track turn-on event can disturb the GPIO pin, see section 12.2.8 to 12.2.9. Therefore, the track turn-on time point is preferably configured to be at the power-switch turn-on point, or earlier, e.g., at the duty-cycle max limit if such is configured in the 'Duty Ctrl' register. The following leading-edge blanking (LEB) time should be configured long enough to cover the ADC Track ejection transients on the GPIO pin, which may be significant during about 0.1-0.5 us depending on GPIO-pin RC network on PCB. The Track time should be long enough to ensure accurate settling of the ADC S/H capacitor, which may be about 0.5us after LEB ends. For example, the Track time could be fixed to 1.0us, and then LEB optimized arbitrarily within 0.1-0.5 us (also considering settling of ACOMP pin).

Another ADC strategy could be to start the Track time at one power-switch turn-on point (or at preceding duty-cycle max limit) and let it continue until just before the next power-switch turn-on point. Then, the A/D conversion is executed during the next PWM period. The drawback of this ADC Track

# LEON3FT Microcontroller

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method is that it will occupy the ADC one whole PWM cycle plus the A/D conversion time, but the benefits are that it will disturb the APWM\_A converter operation the least, and give the most accurate ADC result due to the best possible Track settling.

In section 53.19.2 and 53.19.3, there are examples presented how APWM\_A can control cost-efficient low-power DC/DC converter topologies, based on low-cost bipolar transistors compared to expensive rad-hard MOSFETs. Note that these converters contain only short time constants and delays compared to the PWM period, except for the converter output capacitor,  $C_{OUT}$ , which is designed large enough to maintain a constant output voltage with low ripple throughout a PWM period. Thereby, since GR716B is SET hard, such topologies will be SET hard by design, because the output capacitor will low-pass filter the SETs from all short time constants in these topologies.

## 53.3.2 Registers

TBD

## 53.4 APWM\_CF description

APWM\_CF is a general PWM block configurable for a wide variety of PWM applications. It can work as extension on APWM\_A or AB, using a state input signal, see top left in figure 111. Or, it can work standalone only controlled by Timers and Duty control, which can be updated PWM cycle-by-cycle from RTA or the main LEON3FT.

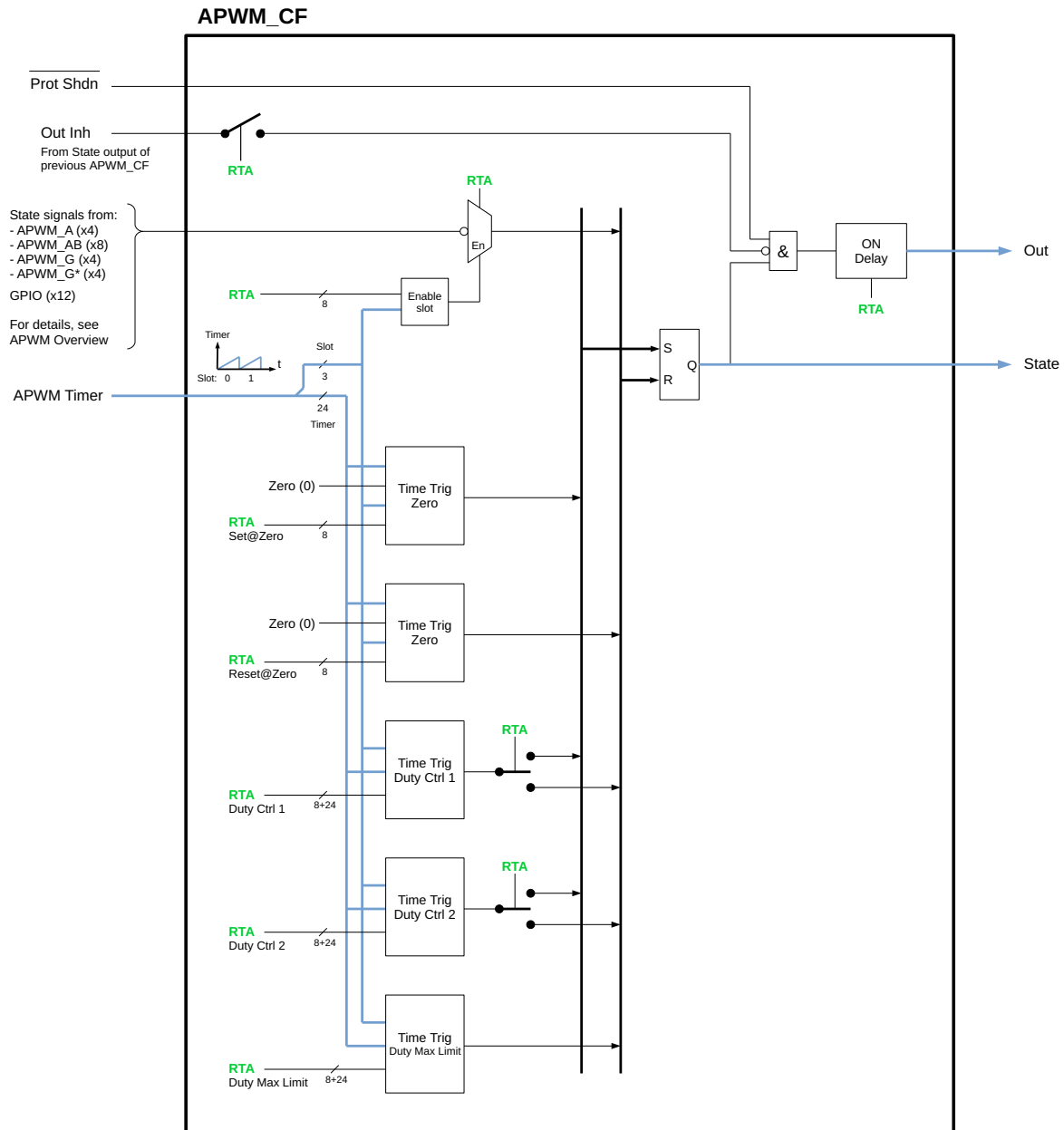


Figure 111. Functional diagram of APWM\_CF

### 53.4.1 Operation

The registers for Timers and Duty control are implemented with double buffering, to support synchronized update of all PWM parameters for all APWM\_CF blocks simultaneously. The synchronization time point when writing takes effect is configurable in each APWM\_CF by event registers and synchronization enable/disable flags controlled from RTA and the main LEON3FT.

Four APWM\_CF blocks use one Timer, see figure 107. If more than four APWM\_CF blocks should run on identical Timer settings, another Timer for another four APWM\_CF blocks is configured identically. This will ensure identical PWM period time and delay position (phase position) on system-clock cycle level, controlled by a Main Timer Tick which is the same selected (configured) for both APWM Timers.

# LEON3FT Microcontroller

When APWM\_CF is configured as extension on APWM\_A or AB, it is typically intended for DC/DC converter topologies that need other than the two PWM outputs from an APWM\_AB block. For example, full-bridge topologies such as phase-shifted full-bridge converters (PSFB) need to use APWM\_CF. Often APWM\_G blocks can be useful also, see section 53.5, which can be configured as further extension on APWM\_CF and APWM\_AB. See section 53.19.4 for a PSFB controller example.

When APWM\_CF is configured to work standalone, both turn-on and off time points can be controlled independently, by writing to Timers and Duty control PWM cycle-by-cycle from RTA, see "RTA" settings to the left in figure 111. This flexible PWM operational mode can be used in many different application areas, such as motor control, voltage-mode DC/DC control, etc.

Motor control can be done in several different ways. For simple motor control, direct control of GPIO outputs can be used. For current-regulation control, PWM control is needed, and this is where APWM\_CF is most suitable. See section 53.19.5 for such a motor control example. For very fast settling of winding currents after commutation time points, GR716B supports peak-current control of winding currents by combining APWM\_CF with APWM\_AB, in a similar way as in the DC/DC controller example in section 53.19.4.

## 53.4.2 Registers

TBD

## 53.5 APWM\_G description

The main functionality of APWM\_G is to provide configurable combinational logic based on the 'state', ACOMP and GPIO input signals, see figure 112 and figure 107. The combinational logic is flexibly configurable to support control of a wide variety of applications including motor control, complex switching DC/DC converters such as phase-shifted full bridge (PSFB) with synchronous rectification, and many other application areas.

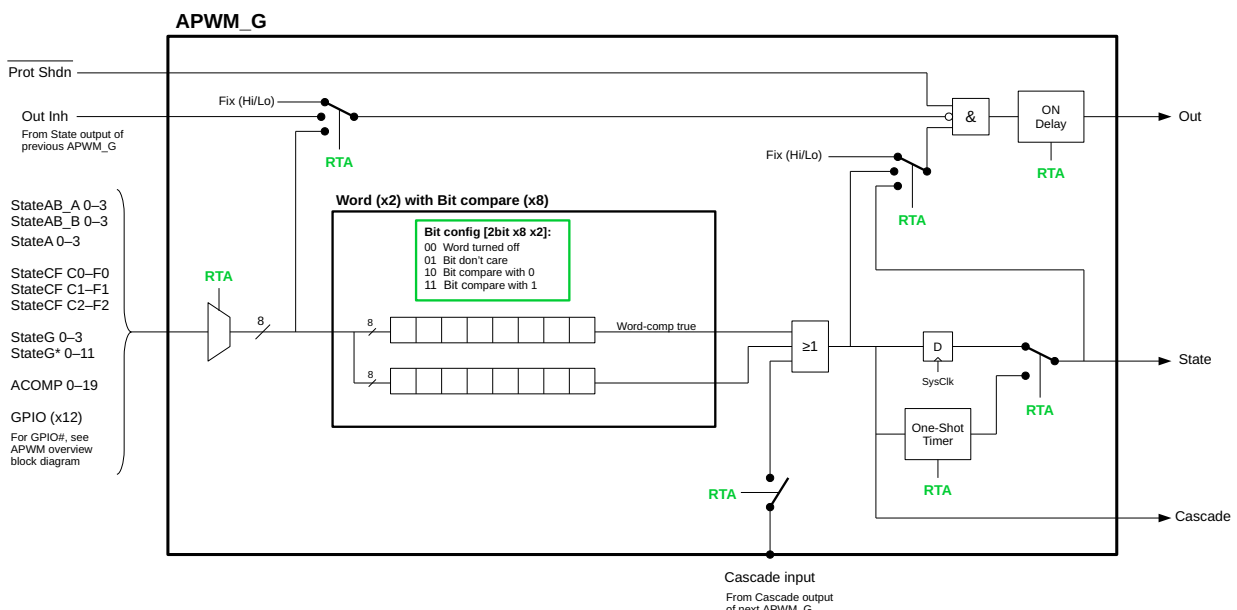


Figure 112. Functional diagram of APWM\_G. Each row is an 8-bit word, and word-compare is true if all 8 bit positions compare to true.

All APWM\_G blocks (x16) have an ON-Delay block at the GPIO output port 'Out'. Four of the APWM\_G blocks have a One-Shot Timer block, and the ones without One-Shot Timer are entitled 'APWM\_G\*' (x12). An APWM\_G block can work standalone with ACOMP and GPIO signals directly connected (configured) as input signals, or work together with APWM\_AB, APWM\_A and APWM\_CF with their state signals connected as inputs, or work with a combination of different inputs.

### 53.5.1 Operation

The combinational logic is structured to execute compare on 8 selected input signals, see to the left in figure 112. There are two rows of such 8-bit comparisons, of which one true row is enough to generate high on the APWM\_G state output. Word-compare true signal is high only when all 8 bit positions are compared to true. Configuration for each bit position is 2 bits, where each position can be configured to compare with logic '0' or '1', or set to don't care. If at least one position in the word is configured to '00', this word is turned off, i.e., its Word-compare true output is forced low.

If two rows would not be enough for a certain application, then neighbor APWM\_G blocks can be configured to work together, see the cascade port in figure 112. This will effectively extend the OR function in APWM\_G with more rows, extended proportionally to the number of APWM\_G blocks that are cascaded. Different ways how to extend or use APWM\_G blocks are further described in the following examples.

An example how to extend APWM\_G to more than 8 effective bits per word is presented here. The bit compare function within a word is an AND function of all 8 bit positions. Upto two inputs of the same type can be connected (configured) into one APWM\_G block, e.g., two StateCF and two ACOMP/GPIO, see table 53.5.2. If an application needs more than two inputs of the same type into the word AND function, multiple APWM\_G blocks can be connected in cascade. It can be done either by connecting the cascade output signal of the neighbor APWM\_G block into the OR gate, or by connecting any state output into the mux input, see figure 113 and 112. A difference between these two cascade methods is that the state output has a pipeline stage (D flip-flop running on system clock, giving upto 10ns delay at 100MHz), whereas the cascade output does not have any pipeline stage. This pipeline D flip-flop constitutes a desired memory function in the second example below, but may cause an undesired delay in other applications.

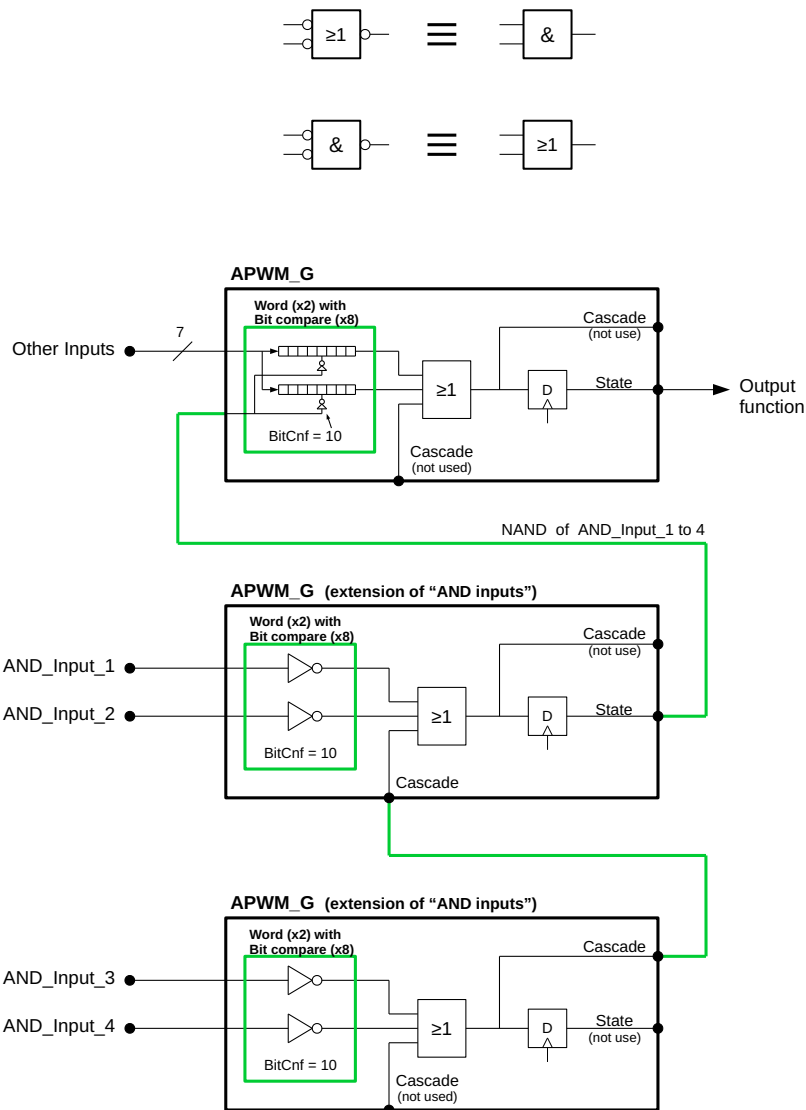


Figure 113. Multiple APWM\_G blocks linked together by cascade and state signals. At the top is a reminder of logic gate equivalents.

From logic truth table it follows that an OR gate with all inputs inverted and the output inverted is equivalent with an AND function, see top of figure 113. This will be used to create an extended word AND function here. At the OR gate in APWM\_G, multiple APWM\_G blocks can be cascaded, which will effectively increase the number of OR inputs in proportion to the number of cascaded blocks. See the cascade signal between the two bottom APWM\_G blocks in figure 113.

To convert these cascaded OR gates to an AND function, each OR-gate input signal is inverted, i.e., configured to compare with zero (BitCnf=10). This is the only function executed by this whole word function, when the purpose is to create this kind of AND function through the OR gates. Therefore, the other seven bit positions in each word are configured to don't care (BitCnf=01). Since there are two words per APWM\_G block, and each of them can invert an input signal, one APWM\_G block supports two input signals. Moreover, if the application would need other logic functions that happens to fit into the other seven bit positions, they are inserted into the bit configurations as desired, instead of setting these positions to don't care.

The state output of the middle APWM\_G block is connected to the mux input of the top block. This mux input signal is inverted when it goes into the word AND function, i.e., configured to compare

# LEON3FT Microcontroller

with zero (BitCnf=10). With this inversion, the inputs, AND\_Input\_1 to 4, are incorporated correctly as extended AND function into the word AND function of the top block. Thereby, the word function will be an AND function of the four input signals, AND\_Input\_1 to 4, and the other seven bit positions in each word of the top block. And each of these two words can have their seven bits, respectively, configured independently. Hence, this configuration implementation has effectively extended the word length of the top APWM\_G block with the inputs AND\_Input\_1 to 4, with the cost of using more APWM\_G blocks.

It depends on the application if the pipeline stage (undesired here), causing 10ns delay to the state output, matters or not. Where it matters, other input signals into the top APWM\_G block that need correlated delay could be configured through another APWM\_G block first, which introduces one pipeline stage. Alternatively, a low-pass RC time constant (>~30ns, for 100MHz system clock) can be added on PCB where this output signal goes out on a GPIO output.

Instead of the state output there is another signal path available, which does not introduce any pipeline delay, but it occupies a GPIO pin. The OR gate output inside the middle APWM\_G block can be configured through the ON-Delay block out on a GPIO pin, without any delay, see figure 112. This GPIO pin can always be read back by its schmitt input, which can be connected to the mux input of the top APWM\_G block. This replaces the state signal from the middle block. If this GPIO pin is left open, or only loaded with resistive load without any noticeable capacitive load, the added delay will be in the order of 1ns. This configuration will effectively work as if the wire from the state output of the middle block in figure 113 is moved to the cascade output, but with a short additional delay of 1ns. Hence, this configuration provides the extended AND function without any pipeline delay, but with the cost of occupying another GPIO pin.

Another example is to configure an APWM\_G block as a synchronously clocked set/reset flip-flop (SR-FF). The D flip-flop in figure 114 is used as the SR-FF memory cell, by connecting the state output back to the mux input of the same APWM\_G block.

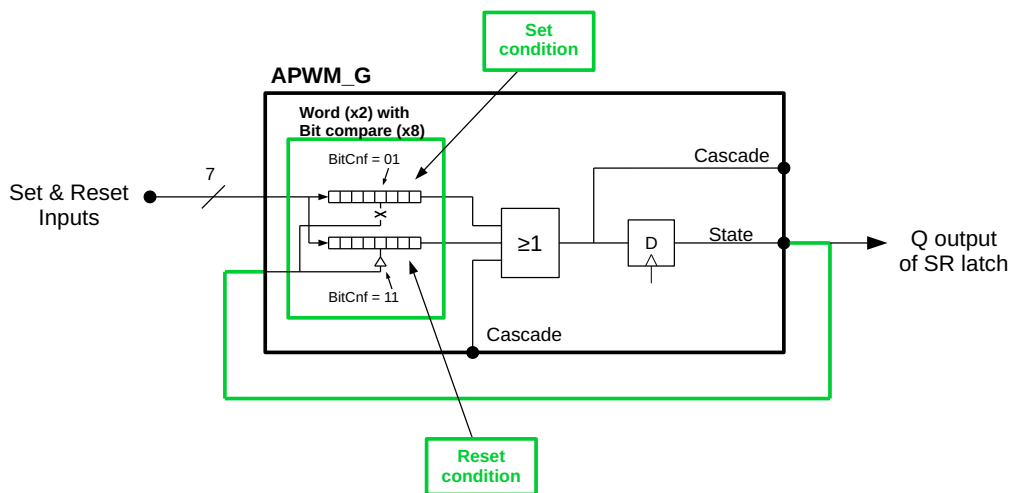


Figure 114. Set-dominant synchronously clocked SR flip-flop.

In this example, the top word is configured to be the set condition. The bottom word is configured to hold the SR-FF memory state in the D flip-flop, by connecting the state output back to the mux input, and configuring this input to compare with one (BitCnf=11). This will permanently lock high state after first clock cycle with a high state signal, assuming the other seven bits are configured to don't care (BitCnf=01). To be able to reset this locked high state, the bottom word needs to also contain a reset condition, configured in the other seven bits. An active reset condition is when at least one of these seven bits goes into the word AND function as low.



# LEON3FT Microcontroller

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If the reset condition only is put in the bottom word, as in figure 114, this will be a set-dominant SR-FF. If the reset condition also is put in the top word, disabling the set function when reset condition is fulfilled, this will be a reset-dominant SR-FF. Instead of putting the reset condition in the top word, the don't care configuration (BitCnf=01) in figure 114 can be changed to compare with zero (BitCnf=10). This will provide an SR-FF that toggles each system clock, when both set and reset conditions are fulfilled continuously. This is traditionally called a JK flip-flop.

The above APWM\_G configuration examples present rather simple straightforward logic functions. An example how to further combine functions is to extend the set and reset conditions in the SR-FF example by the word extension method in figure 113. Then, the top APWM\_G block constitutes the SR-FF block.

In general, numerous variations of arbitrary logic functions can be defined in multiple APWM\_G blocks, where upto 4 APWM\_G blocks (with one-shot timer) resp 12 APWM\_G\* blocks (without one-shot timer) can be connected in cascade. Furthermore, any state signals throughout such cascade chains can be connected to mux inputs of any APWM\_G blocks or connected to GPIO outputs through the ON-Delay block. So this configuration flexibility of APWM\_G should be able to support a great variety of application situations.

## 53.5.2 Registers

TBD

## 53.6 Timers and Synchronization

Timers and synchronization blocks are distributed over a few central timers and multiple local timers in all 'APWM' blocks, to support both multiple independent operation/functions and/or synchronization operations, see overview figure 107. In the event of synchronized operations, local timers should have identical timer setting, i.e., same synchronization source should be selected and integer multiple of cycle time.

Central timers of the APWM (Timers in top left corner in figure 107) can generate synchronization to internal APWM logic, and to others GR716B devices to synchronize multiple GR716B. Thus, the central timers of the APWM (Timers in top left corner in Figure 107) can be configured to synchronize local timers to external timing.

To achieve high system reliability in critical applications, a System Clock Detector in the synchronization block continuously monitor the system clock for anomalies.

## 53.7 Alarm Matrix and Shutdown

The APWM unit provides protection alarm signals, going to the central protection configuration matrix on the chip. In this matrix, the user configures which protection shutdown signals that shall be activated, based on all incoming alarm signals. Alarm input signals are from ACOMP, FIR limit trig, GPIO, and internal health-check monitors. Shutdown signals out from the matrix are, e.g., the protection shutdown signals that go to each APWM block and do protection shutdown of the PWM output signal, e.g., connected to power switches in DC/DC applications. Also, a number of shutdown signals are configurable to GPIO outputs.

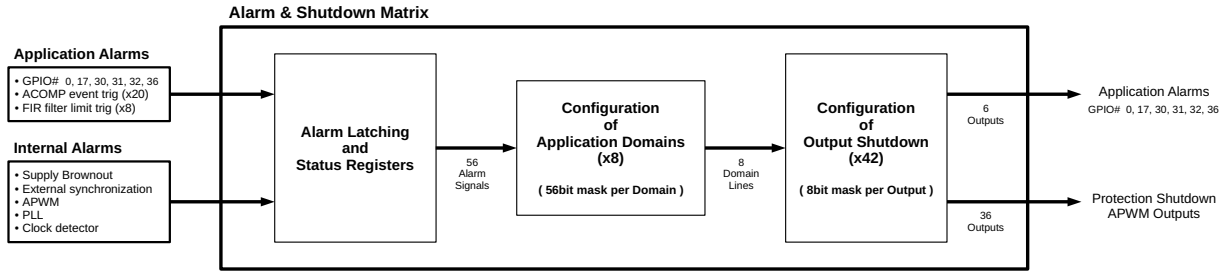


Figure 115. Block diagram of the Alarm and Shutdown Matrix.

### 53.8 Registers

The core is programmed through registers mapped into APB address space.

Table 673. APWM registers

Function	APB address offset	Register
TIMER32	0x81000000 - 0x810000FF	APWM system timer and synchronization 0
TIMER32	0x81001000 - 0x810010FF	APWM system timer and synchronization 1
REGSYNC	0x81002000 - 0x810020FF	APWM Register synchronization
PROTSHDN	0x81003000 - 0x810030FF	Protection shutdown 0
PROTSHDN	0x81004000 - 0x810040FF	Protection shutdown 1
PROTSHDN	0x81005000 - 0x810050FF	Protection shutdown 2
SYNC	0x81006000 - 0x810060FF	External synchronization
CLKDET	0x8100D000 - 0x8100D0FF	Clock error detection 0
TIMER27	0x8100E000 - 0x8100E0FF	APWM function timer and synchronization 0
TIMER27	0x8100F000 - 0x8100F0FF	APWM function timer and synchronization 1
REGSYNC_A	0x81100000 - 0x811000FF	APWM A0 Timer and synchronization
APWM_A	0x81101000 - 0x811010FF	APWM A0 0
APWM_A	0x81102000 - 0x811020FF	APWM A0 1
APWM_A	0x81103000 - 0x811030FF	APWM A0 2
APWM_A	0x81104000 - 0x811040FF	APWM A0 3
CLOCKDET	0x8110B000 - 0x8110B0FF	Clock error detection 1
TIMESTAMP	0x8110C000 - 0x8110C0FF	APWM Timestamp
REGSYNCAB	0x81200000 - 0x812000FF	APWM AB0 Timer and synchronization
APWMAB	0x81201000 - 0x812010FF	APWM AB0
REGSYNC_AB	0x81202000 - 0x812020FF	APWM AB1 Timer and synchronization
APWM_AB	0x81203000 - 0x812030FF	APWM AB1
REGSYNC_AB	0x81204000 - 0x812040FF	APWM AB2 Timer and synchronization
APWM_AB	0x81205000 - 0x812050FF	APWM AB2
REGSYNC_AB	0x81206000 - 0x812060FF	APWM AB3 Timer and synchronization
APWM_AB0	0x81207000 - 0x812070FF	APWM AB3
REGSYNC_CF	0x81300000 - 0x813000FF	APWM CF0 Timer and synchronization
APWM_CF	0x81301000 - 0x813010FF	APWM CF0 0

# LEON3FT Microcontroller

Table 673. APWM registers

Function	APB address offset	Register
APWM_CF	0x81302000 - 0x813020FF	APWM CF0 1
APWM_CF	0x81303000 - 0x813030FF	APWM CF0 2
APWM_CF	0x81304000 - 0x813040FF	APWM CF0 3
REGSYNC_CF	0x81305000 - 0x813050FF	APWM CF1 Timer and synchronization
APWM_CF	0x81306000 - 0x813060FF	APWM CF1 0
APWM_CF	0x81307000 - 0x813070FF	APWM CF1 1
APWM_CF	0x81308000 - 0x813080FF	APWM CF1 2
APWM_CF	0x81309000 - 0x813090FF	APWM CF1 3
REGSYNC_CF	0x81400000 - 0x814000FF	APWM CF2 Timer and synchronization
APWM_CF	0x81401000 - 0x814010FF	APWM CF2 0
APWM_CF	0x81402000 - 0x814020FF	APWM CF2 1
APWM_CF	0x81403000 - 0x814030FF	APWM CF2 2
APWM_CF	0x81404000 - 0x814040FF	APWM CF2 3
APWM_G	0x81500000 - 0x815000FF	APWMG 0
APWM_G	0x81501000 - 0x815010FF	APWMG 1
APWM_G	0x81502000 - 0x815020FF	APWMG 2
APWM_G	0x81503000 - 0x815030FF	APWMG 3
APWM_G	0x81504000 - 0x815040FF	APWMG 4
APWM_G	0x81505000 - 0x815050FF	APWMG 5
APWM_G	0x81506000 - 0x815060FF	APWMG 6
APWM_G	0x81507000 - 0x815070FF	APWMG 7
APWM_G	0x81508000 - 0x815080FF	APWMG 8
APWM_G	0x81509000 - 0x815090FF	APWMG 9
APWM_G	0x8150A000 - 0x8150A0FF	APWMG 10
APWM_G	0x8150A000 - 0x8150A0FF	APWMG 10
APWM_G	0x8150B000 - 0x8150B0FF	APWMG 11
APWM_G	0x8150C000 - 0x8150C0FF	APWMG 12
APWM_G	0x8150D000 - 0x8150D0FF	APWMG 13
APWM_G	0x8150E000 - 0x8150E0FF	APWMG 14
APWM_G	0x8150F000 - 0x8150F0FF	APWMG 15

# LEON3FT Microcontroller

## 53.9 System Timers

### 53.9.1 Registers

The core is programmed through registers mapped into APB address space.

Table 674. System Timers A and B registers

APB address offset	Register
0x81000000	TIMER 32 A Status register
0x81000004	TIMER 32 A Interrupt register
0x81000008	TIMER 32 A Mask register
0x8100000C	TIMER 32 A Interrupt level register
0x81000010	TIMER 32 A Select synchronization source
0x81000014	TIMER 32 A System period
0x81000018	TIMER 32 A Timer Tick 0
0x8100001C	TIMER 32 A Timer Tick 1
0x81000020	TIMER 32 A Timer Tick 2
0x81000024	TIMER 32 A Timer Tick 3
0x81000028	TIMER 32 A Timer Tick 4
0x8100002c	TIMER 32 A Timer Tick 5
0x81000030	TIMER 32 A Timer Tick 6
0x81000034	TIMER 32 A Timer Tick 7
0x81000080	TIMER 32 A Timer counter value
0x810000E0	TIMER 32 A Local register interface information
0x810000F0	TIMER 32 A Check bits for configuration register 0 to 7
0x810000F4	TIMER 32 A Check bits for configuration register 8 to 15
0x810000F8	TIMER 32 A Status check bits for configuration register 0 to 7
0x810000FC	TIMER 32 A Status check bits for configuration register 8 to 15
0x81001000 - 0x810010FF <sup>1)</sup>	TIMER 32 B

Note 1: TIMER 32 B has the same register as TIMER 32 A with a different offset

# LEON3FT Microcontroller

## 53.10 APWM REGSYNC

### 53.10.1 Registers

The core is programmed through registers mapped into APB address space.

Table 675. System Timers A and B registers

APB address offset	Register
0x81000000	REGSYNC Status register
0x81000004	REGSYNC Interrupt register
0x81000008	REGSYNC Mask register
0x8100000C	REGSYNC Interrupt level register
0x81000010	REGSYNC RTA0 set mask for A and AB
0x81000014	REGSYNC RTA0 Reset mask for A and AB
0x81000018	REGSYNC RTA1 set mask for A and AB
0x8100001C	REGSYNC RTA1 Reset mask for A and AB
0x81000020	REGSYNC CPU0 set mask for A and AB
0x81000024	REGSYNC CPU0 reset mask for A and AB
0x81000010	REGSYNC RTA0 set mask for CF
0x81000014	REGSYNC RTA0 Reset mask for CF
0x81000018	REGSYNC RTA1 set mask for CF
0x8100001C	REGSYNC RTA1 Reset mask for CF
0x81000020	REGSYNC CPU0 set mask for CF
0x81000024	REGSYNC CPU0 reset mask for CF
0x81000080	REGSYNC Status of register synchronization for A and AB
0x81000084	REGSYNC Status of register synchronization for CF
0x810000E0	REGSYNC Local register interface information
0x810000F0	REGSYNC Check bits for configuration register 0 to 7
0x810000F4	REGSYNC Check bits for configuration register 8 to 15
0x810000F8	REGSYNC Status check bits for configuration register 0 to 7
0x810000FC	REGSYNC Status check bits for configuration register 8 to 15

# LEON3FT Microcontroller

## 53.11 Protection shutdown

### 53.11.1 Alarm Protection A Registers

The core is programmed through registers mapped into APB address space.

Table 676. Alarm protection A registers

APB address offset	Register
0x81003000	Alarm protection APP Status register
0x81003004	Alarm protection APP Interrupt register
0x81003008	Alarm protection APP Mask register
0x8100300C	Alarm protection APP Interrupt level register
	Config for Bit-masking plus OR:ing for Application Alarm Lines (32 * 8) + (24 * 8)
0x81003010	Alarm protection APP_0_0_REG
0x81003014	Alarm protection APP_0_1_REG
0x81003018	Alarm protection APP_1_0_REG
0x8100301C	Alarm protection APP_1_1_REG
0x81003020	Alarm protection APP_2_0_REG
0x81003024	Alarm protection APP_2_1_REG
0x81003028	Alarm protection APP_3_0_REG
0x8100302C	Alarm protection APP_3_1_REG
0x81003030	Alarm protection APP_4_0_REG
0x81003034	Alarm protection APP_4_1_REG
0x81003038	Alarm protection APP_5_0_REG
0x8100303C	Alarm protection APP_5_1_REG
0x81003040	Alarm protection APP_6_0_REG
0x81003044	Alarm protection APP_6_1_REG
0x81003048	Alarm protection APP_7_0_REG
0x8100304C	Alarm protection APP_7_1_REG
0x81003080	Alarm protection Bus status A
0x810030E0	Alarm protection APP Local register interface information
0x810030F0	Alarm protection APP Check bits for configuration register 0 to 7
0x810030F4	Alarm protection APP Check bits for configuration register 8 to 15
0x810030F8	Alarm protection APP Status check bits for configuration register 0 to 7
0x810030FC	Alarm protection APP Status check bits for configuration register 8 to 15

# LEON3FT Microcontroller

## 53.11.2 Alarm Protection B Registers

The core is programmed through registers mapped into APB address space.

Table 677. Alarm protection B registers

APB address offset	Register
0x81004000	Alarm protection shutdown Status register
0x81004004	Alarm protection shutdown Interrupt register
0x81004008	Alarm protection shutdown Mask register
0x8100400C	Alarm protection shutdown Interrupt level register
	Config for Bit-masking plus OR:ing for GPIO/AB/A/CF/G protection shutdown (42*8)
0x81004010	Alarm protection shutdown 0_REG
0x81004014	Alarm protection shutdown 1_REG
0x81004018	Alarm protection shutdown 2_REG
0x8100401C	Alarm protection shutdown 2_REG
0x81004020	Alarm protection shutdown 3_REG
0x81004024	Alarm protection shutdown 4_REG
0x81004028	Alarm protection shutdown 5_REG
0x8100402C	Alarm protection shutdown 6_REG
0x81004030	Alarm protection shutdown 7_REG
0x81004034	Alarm protection shutdown 8_REG
0x81004038	Alarm protection shutdown 9_REG
0x8100403C	Alarm protection shutdown 10_REG
0x81004080	Alarm protection Bus status B
0x810040E0	Alarm protection shutdown Local register interface information
0x810040F0	Alarm protection shutdown Check bits for configuration register 0 to 7
0x810040F4	Alarm protection shutdown Check bits for configuration register 8 to 15
0x810040F8	Alarm protection shutdown Status check bits for configuration register 0 to 7
0x810040FC	Alarm protection shutdown Status check bits for configuration register 8 to 15

# LEON3FT Microcontroller

## 53.11.3 Alarm protection C Registers

The core is programmed through registers mapped into APB address space.

Table 678. Alarm protection C registers

APB address offset	Register
0x81005000	Alarm protection Set clear Status register
0x81005004	Alarm protection Set clear Interrupt register
0x81005008	Alarm protection Set clear Mask register
0x8100500C	Alarm protection Set clear Interrupt level register
0x81005010	Alarm protection Set alarm 0
0x81005014	Alarm protection Set alarm 1
0x81005018	Alarm protection Clear alarm 0
0x8100501C	Alarm protection Clear alarm 1
0x81005020	Alarm protection SR write arm
0x81005080	Alarm protection Bus status C
0x810050E0	Alarm protection shutdown Local register interface information
0x810050F0	Alarm protection shutdown Check bits for configuration register 0 to 7
0x810050F4	Alarm protection shutdown Check bits for configuration register 8 to 15
0x810050F8	Alarm protection shutdown Status check bits for configuration register 0 to 7
0x810050FC	Alarm protection shutdown Status check bits for configuration register 8 to 15



# LEON3FT Microcontroller

## 53.12 External Sync Control

### 53.12.1 Registers

The core is programmed through registers mapped into APB address space.

Table 679. External Sync Control registers

APB address offset	Register
0x81006000	Status register
0x81006004	Interrupt register
0x81006008	Mask register
0x8100600C	Interrupt level register
0x81006010	Block 0 Select input GPIO number (0, 17, 30, 31, 32) (GPIO with schmitt used)
0x81006014	Block 0 Preset value for 12 bit counter
0x81006018	Block 0 Number of external sync pulses for resynch
0x8100601C	Block 1 Select input GPIO number (0, 17, 30, 31, 32) (GPIO with schmitt used)
0x81006020	Block 1 Preset value for 12 bit counter
0x81006024	Block 1 Number of external sync pulses for resynch
0x81006080	Block 0 Shift Register status
0x81006084	Block 1 Shift Register status
0x810060E0	Local register interface information
0x810060F0	Check bits for configuration register 0 to 7
0x810060F4	Check bits for configuration register 8 to 15
0x810060F8	Status check bits for configuration register 0 to 7
0x810060FC	Status check bits for configuration register 8 to 15

# LEON3FT Microcontroller

## 53.13 Clock Error Detect

### 53.13.1 Registers

The core is programmed through registers mapped into APB address space.

Table 680. Clock Error detect registers

APB address offset	Register
0x8100D000	Status register
0x8100D004	Interrupt register
0x8100D008	Mask register
0x8100D00C	Interrupt level register
0x8100D010	Mux Configuration for ClkDiv
0x8100D014	Min value configuration for SysClkDet_A
0x8100D018	Max value configuration for SysClkDet_A
0x8100D01C	Min value configuration for SysClkDet_B
0x8100D020	Max value configuration for SysClkDet_B
0x8100D024	Reserved
0x8100D028	Reserved
0x8100D02C	Input data and mux enable for input data from CPU
0x8100D030	Oscillator Enable
0x8100D080	Counter value from SysClkDet_A
0x8100D084	Counter value from SysClkDet_B
0x8100D088	Valid signal from SysClkDet_A
0x8100D08C	Valid signal from SysClkDet_B
0x8100D090	Error signal from SysClkDet_A
0x8100D094	Error signal from SysClkDet_B
0x8100D098	Clock detect latch SysClk_Ok
0x8100D0E0	Local register interface information
0x8100D0F0	Check bits for configuration register 0 to 7
0x8100D0F4	Check bits for configuration register 8 to 15
0x8100D0F8	Status check bits for configuration register 0 to 7
0x8100D0FC	Status check bits for configuration register 8 to 15
0x8110B000 - 0x8110B0FF <sup>1)</sup>	Clock error detection 1

# LEON3FT Microcontroller

## 53.14 APWM A

### 53.14.1 Registers

The core is programmed through registers mapped into APB address space.

Table 681. APWM A registers

APB address offset	Register
0x81101000	APWM A 0 Status register
0x81101004	APWM A 0 Interrupt register
0x81101008	APWM A 0 Mask register
0x8110100C	APWM A 0 Interrupt level register
0x81101010	APWM A 0 State configuration (S)
0x81101014	APWM A 0 RTA Duty Control (R)
0x81101018	APWM A 0 SR_DUAL Configuration
0x8110101C	APWM A 0 LEB Control
0x81101020	APWM A 0 Max duty cycle control
0x81101080	APWM A 0 Timer stamp
0x81101084	APWM A 0 Timer value
0x811010E0	APWM A 0 Local register interface information
0x811010F0	APWM A 0 Check bits for configuration register 0 to 7
0x811010F4	APWM A 0 Check bits for configuration register 8 to 15
0x811010F8	APWM A 0 Status check bits for configuration register 0 to 7
0x811010FC	APWM A 0 Status check bits for configuration register 8 to 15
0x81102000 - 0x811020FF <sup>1)</sup>	APWM A 1
0x81103000 - 0x811030FF <sup>1)</sup>	APWM A 2
0x81104000 - 0x811040FF <sup>1)</sup>	APWM A 3

Note 1: APWM A1, 2 and 3 has the same registers as APWM A 0 with a different offset

# LEON3FT Microcontroller

## 53.15 APWM AB

### 53.15.1 Registers

The core is programmed through registers mapped into APB address space.

Table 682. APWM\_AB registers

APB address offset	Register
0x81201000	APWM AB 0 Status register
0x81201004	APWM AB 0 Interrupt register
0x81201008	APWM AB 0 Mask register
0x8120100C	APWM AB 0 Interrupt level register
0x81201010	APWM AB 0 RTA Duty Cycle
0x81201014	APWM AB 0 State A SR_DUAL Configuration
0x81201018	APWM AB 0 RTA Rect Control
0x8120101C	APWM AB 0 STATE B SR_DUAL Configuration
0x81201020	APWM AB 0 LEB control
0x81201024	APWM AB 0 TEB control
0x81201028	APWM AB 0 On delay timer configuration A
0x8120102C	APWM AB 0 On delay timer configuration B
0x81201030	APWM AB 0 Max duty cycle
0x81201034	APWM AB 0 Zero counter
0x81201080	APWM AB 0 Timer stamp
0x81201084	APWM AB 0 Timer value
0x812010E0	APWM AB 0 Local register interface information
0x812010F0	APWM AB 0 Check bits for configuration register 0 to 7
0x812010F4	APWM AB 0 Check bits for configuration register 8 to 15
0x812010F8	APWM AB 0 Status check bits for configuration register 0 to 7
0x812010FC	APWM AB 0 Status check bits for configuration register 8 to 15
0x81203000 - 0x812030FF <sup>1)</sup>	APWM AB 1
0x81205000 - 0x812050FF <sup>1)</sup>	APWM AB 2
0x81207000 - 0x812070FF <sup>1)</sup>	APWM AB 3

Note 1: APWM AB 1, 2 and 3 has the same registers as APWM AB 0 with a different offset

# LEON3FT Microcontroller

## 53.16 APWM CF

### 53.16.1 Registers

The core is programmed through registers mapped into APB address space.

Table 683. APWM\_CF registers

APB address offset	Register
0x81301000	APWM CF0 0 Status register
0x81301004	APWM CF0 0 Interrupt register
0x81301008	APWM CF0 0 Mask register
0x8130100C	APWM CF0 0 Interrupt level register
0x81301010	APWM CF0 0 Enable use of lower state
0x81301014	APWM CF0 0 Configuration of On delay counter
0x81301018	APWM CF0 0 Select disable input state for PWM
0x8130101C	APWM CF0 0 Configure internal disable state
0x81301020	APWM CF0 0 Configure time-slots multiplexer (CMPE)
0x81301024	APWM CF0 0 Enable CMPE i.e. zero block
0x81301028	APWM CF0 0 Configure time-slots multiplexer (CMP)

# LEON3FT Microcontroller

Table 683. APWM\_CF registers

APB address offset	Register
0x8130102C	APWM CF0 0 Enable CMP i.e. zero block
0x81301030	APWM CF0 0 Count Cnf 0
0x81301034	APWM CF0 0 Select CmpEQ 1
0x81301038	APWM CF0 0 Count Cnf 1
0x8130103c	APWM CF0 0 Select CmpEQ 2
0x81301040	APWM CF0 0 Max duty check
0x81301044	APWM CF0 0 RTA Sync setup 0 and 1
0x81301048	APWM CF0 0 RTA Sync Reg 0
0x8130104c	APWM CF0 0 RTA Sync Reg 1
0x81301080	APWM CF0 0 Counter input value
0x81301084	APWM CF0 0 Input state value
0x81301088	APWM CF0 0 RTA Duty cycle output value 0
0x8130108C	APWM CF0 0 RTA Duty cycle output value 1
0x813010E0	APWM CF0 0 Local register interface information
0x813010F0	APWM CF0 0 Check bits for configuration register 0 to 7
0x813010F4	APWM CF0 0 Check bits for configuration register 8 to 15
0x813010F8	APWM CF0 0 Status check bits for configuration register 0 to 7
0x813010FC	APWM CF0 0 Status check bits for configuration register 8 to 15
0x81302000 - 0x813020FF <sup>1)</sup>	APWM CF0 1
0x81303000 - 0x813030FF <sup>1)</sup>	APWM CF0 2
0x81304000 - 0x813040FF <sup>1)</sup>	APWM CF0 3
0x81306000 - 0x813060FF <sup>1)</sup>	APWM CF1 0
0x81307000 - 0x813070FF <sup>1)</sup>	APWM CF1 1
0x81308000 - 0x813080FF <sup>1)</sup>	APWM CF1 2
0x81309000 - 0x813090FF <sup>1)</sup>	APWM CF1 3
0x81401000 - 0x813010FF <sup>1)</sup>	APWM CF2 0
0x81402000 - 0x813020FF <sup>1)</sup>	APWM CF2 1
0x81403000 - 0x813030FF <sup>1)</sup>	APWM CF2 2
0x81404000 - 0x813040FF <sup>1)</sup>	APWM CF2 3

Note 1: APWM CF0 123, CF1 0123 and CF2 0123 has the same registers as APWM CF0 0 with a different offset

# LEON3FT Microcontroller

## 53.17 APWM G

### 53.17.1 Registers

The core is programmed through registers mapped into APB address space.

Table 684. APWM G registers

APB address offset	Register
0x81500000	APWM G 0 Status register
0x81500004	APWM G 0 Interrupt register
0x81500008	APWM G 0 Mask register
0x8150000C	APWM G 0 Interrupt level register
0x81500010	APWM G 0 On delay timer configuration
0x81500014	APWM G 0 CmpG_word configuration
0x81500018	APWM G 0 Enable input and state
0x8150001C	APWM G 0 Select state 0 to 3
0x81500020	APWM G 0 Select state 4 to 7
0x81500024	APWM G 0 Select output state source
0x81500028	APWM G 0 Enable One Shot trigger
0x8150002C	APWM G 0 Preset value for One Shot timer
0x81500030	APWM G 0 Configure One Shot output
0x81500080	APWM G 0 Input states 31 downto 0
0x81500084	APWM G 0 Input states 63 downto 32
0x815000E0	APWM G 0 Local register interface information
0x815000F0	APWM G 0 Check bits for configuration register 0 to 7
0x815000F4	APWM G 0 Check bits for configuration register 8 to 15
0x815000F8	APWM G 0 Status check bits for configuration register 0 to 7
0x815000FC	APWM G 0 Status check bits for configuration register 8 to 15
0x81501000 - 0x811010FF <sup>1)</sup>	APWM G 1
0x81502000 - 0x811020FF <sup>1)</sup>	APWM G 2
0x81503000 - 0x811030FF <sup>1)</sup>	APWM G 3

Note 1: APWM G 1, 2 and 3 has the same registers as APWM G 0 with a different offset

# LEON3FT Microcontroller

## 53.18 APWM G\*

### 53.18.1 Registers

The core is programmed through registers mapped into APB address space.

Table 685. APWM G\* registers

APB address offset	Register
0x81504000	APWM G* 0 Status register
0x81504004	APWM G* 0 Interrupt register
0x81504008	APWM G* 0 Mask register
0x8150400C	APWM G* 0 Interrupt level register
0x81504010	APWM G* 0 On delay timer configuration
0x81504014	APWM G* 0 CmpG_word configuration
0x81504018	APWM G* 0 Enable input and state
0x8150401C	APWM G* 0 Select state 0 to 3
0x81504020	APWM G* 0 Select state 4 to 7
0x81504024	APWM G* 0 Select output state source
0x81504080	APWM G* 0 Input states 31 downto 0
0x81504084	APWM G* 0 Input states 63 downto 32
0x815040E0	APWM G* 0 Local register interface information
0x815040F0	APWM G* 0 Check bits for configuration register 0 to 7
0x815040F4	APWM G* 0 Check bits for configuration register 8 to 15
0x815040F8	APWM G* 0 Status check bits for configuration register 0 to 7
0x815040FC	APWM G* 0 Status check bits for configuration register 8 to 15
0x81505000 - 0x811050FF <sup>1)</sup>	APWM G* 1
0x81506000 - 0x811060FF <sup>1)</sup>	APWM G* 2
0x81507000 - 0x811070FF <sup>1)</sup>	APWM G* 3
0x81508000 - 0x811080FF <sup>1)</sup>	APWM G* 4
0x81509000 - 0x811090FF <sup>1)</sup>	APWM G* 5
0x8150A000 - 0x8110A0FF <sup>1)</sup>	APWM G* 6
0x8150B000 - 0x8110B0FF <sup>1)</sup>	APWM G* 7
0x8150C000 - 0x8110C0FF <sup>1)</sup>	APWM G* 8
0x8150D000 - 0x8110D0FF <sup>1)</sup>	APWM G* 9
0x8150E000 - 0x8110E0FF <sup>1)</sup>	APWM G* 10
0x8150F000 - 0x8110F0FF <sup>1)</sup>	APWM G* 11

Note 1: APWM G\* 1 to 15 has the same registers as APWM G\* 0 with a different offset



## 53.19 Application Notes for APWM Controllers

### 53.19.1 APWM\_AB application: DC/DC converter connection examples

Examples of GR716B connection diagrams for commonly used DC/DC topologies in the industry are presented in figure 116. Frequency controlled topologies such as resonant LLC converters are also supported, since the PWM frequency from APWM Timer is cycle-by-cycle reprogrammable from RTA. An example how to control a more complex DC/DC topology such as a phase-shifted full-bridge converter (PSFB) is presented in section 53.4. That DC/DC converter uses APWM\_CF and APWM\_G, in addition to APWM\_AB.

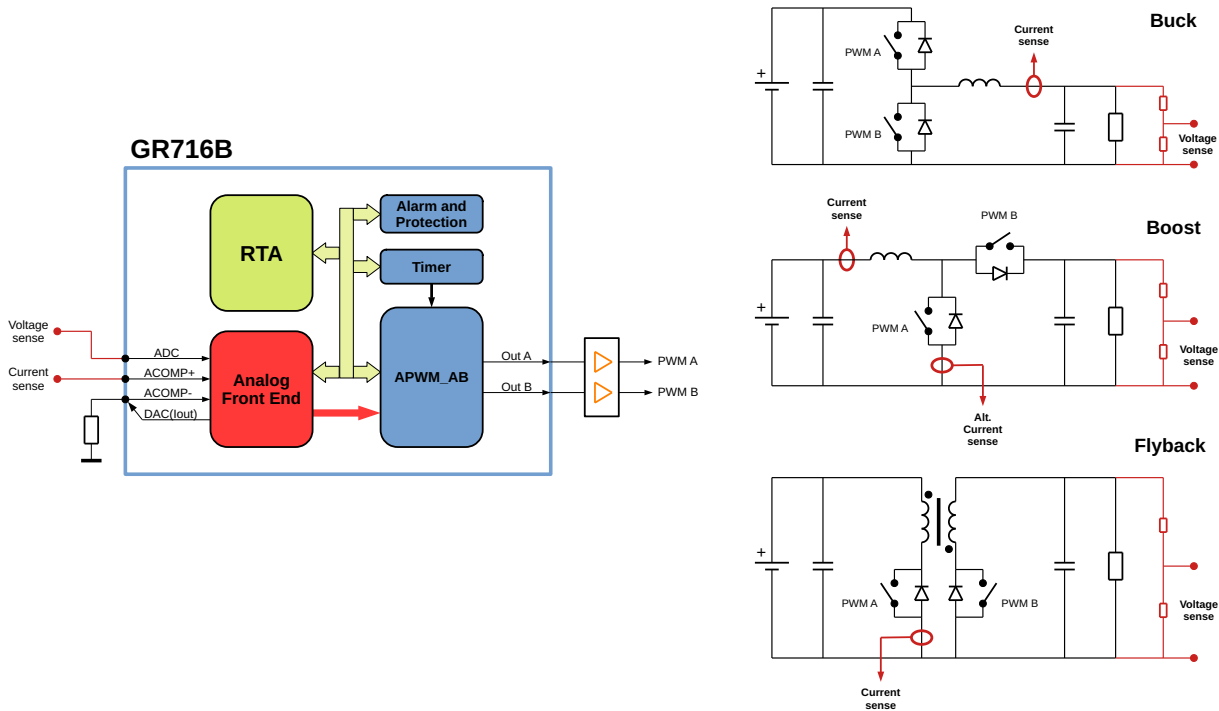


Figure 116. Simplified application schematics of DC/DC converters controlled by APWM\_AB: step-down (buck), step-up (boost), and flyback (buck-boost).

The step-down (buck) converter only can convert to lower output voltage than its input voltage, therefore from the name step-down converter. The step-up (boost) converter only can convert to higher output voltage, which means that special care must be taken during start-up from zero output voltage until it is higher than the input voltage. The flyback (buck-boost) can convert seamlessly to lower or higher output voltage than its input voltage.

The Out A signal controls the duty-cycle switch, i.e., the PWM A switch, which always is required in these switching power topologies. The Out B signal controls the synchronous-rectification switch, i.e., the PWM B switch. This switch is optional, and can be replaced by a diode when power efficiency is of less importance. In the order of 10A and higher output currents, this switch is normally beneficial to implement, and for the order of 1A and lower it is often not space and cost efficient compared to the benefits.

The class of point-of-load (POL) converters is commonly implemented with step-down (buck) converters. A main reason is that the output voltage from a POL converter is usually rather low, commonly in the range 0.5-5 V, and needs to be accurately regulated close to the physical point of load to not get too large voltage drop in the supply distribution net. The maximum output current to be designed for a POL converter can vary in a large span, usually somewhere in the range of 1A to 50A.

# LEON3FT Microcontroller

When designing for the upper end of this range, large load-current changes can occur, which also can have fast rise and fall times in many applications, e.g., in supplies for digital ICs such as FPGAs.

A special duty-cycle control case for POL converters is, therefore, to handle extraordinarily large and fast load-current changes. Then, the duty cycle needs to change quickly and to a large extent, preferably with a step of the whole allowed duty-cycle change within one or a couple of power-switch cycles. This may be difficult to accommodate fast enough in a conventional digital control-law algorithm. First, the load change must be detected by the ADC voltage measurement, including sample sanity check to not jump to conclusions based on one faulty or disturbed ADC sample. Second, the RTA needs to detect and conclude that a large load-step has occurred, and apply a special control-law algorithm for a limited period in time.

An alternative solution for such load change cases is provided by GR716B. An analog comparator, ACOMP, can be configured to detect a fixed converter output-voltage level, and trig the one-shot timer in APWM\_G, see figure 117. The one-shot timer output is combined with the APWM\_AB outputs in two other APWM\_G such that when no ACOMP has triggered the APWM\_AB controls the power switches as in normal APWM\_AB operation. When ACOMP has triggered, the power switches are controlled by the one-shot timer such that a duty-switch turn-on is generated if the output voltage is too low, or a rectification-switch turn-on is generated if the output voltage is too high. The pulse length from the one-shot timer is configurable from RTA.

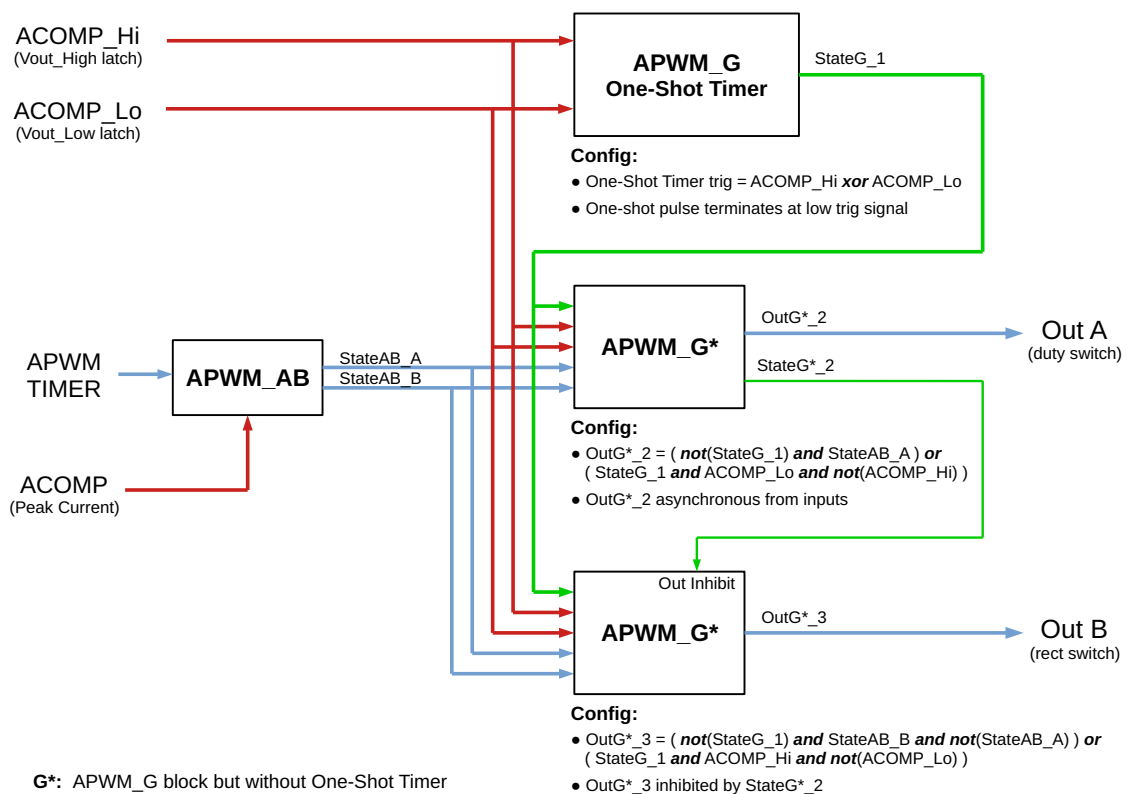


Figure 117. GR716B configuration diagram for ACOMP level-triggered duty control, to handle large and fast load-current changes in step-down (buck) converters in general.

This solution gives the converter similar reaction time to load changes as in hysteretic-controlled converters, which are known to perform well in POL applications. An essential benefit with ACOMP level-triggered duty control is the fast ACOMP reaction time of about 100ns, when configured to SET-hard mode. Moreover, the risk of uncertain delay due to ADC sample sanity-check error is eliminated. Hence, the extraordinary load change cases for POL converters are more robustly and safely handled by this GR716B solution than ADC-based solutions, especially in space environment where ADC samples can be subject to heavy-ion corruption randomly.

# LEON3FT Microcontroller

## 53.19.2 APWM\_A application: A low-power DC/DC converter

The low-power DC/DC converter in figure 118 will be used to present the detailed operation of APWM\_A. The controller is based on ACOMP in peak-voltage mode, without use of RTA, ADC or DAC. A controller for multiple low-power DC/DC converters, based on one ACOMP and APWM\_A combined with multiple APWM\_CF blocks, is presented thereafter.

*General note:* Component types and values in schematics should be interpreted as recommendations of right order of magnitude, presented to illustrate the functionality of the circuit topologies. They do not guarantee performance in worst-case corners, which needs to be guaranteed by detailed parts stress and worst case analyses based on your exact component types and values including tolerances and all other electrical properties in your designs.

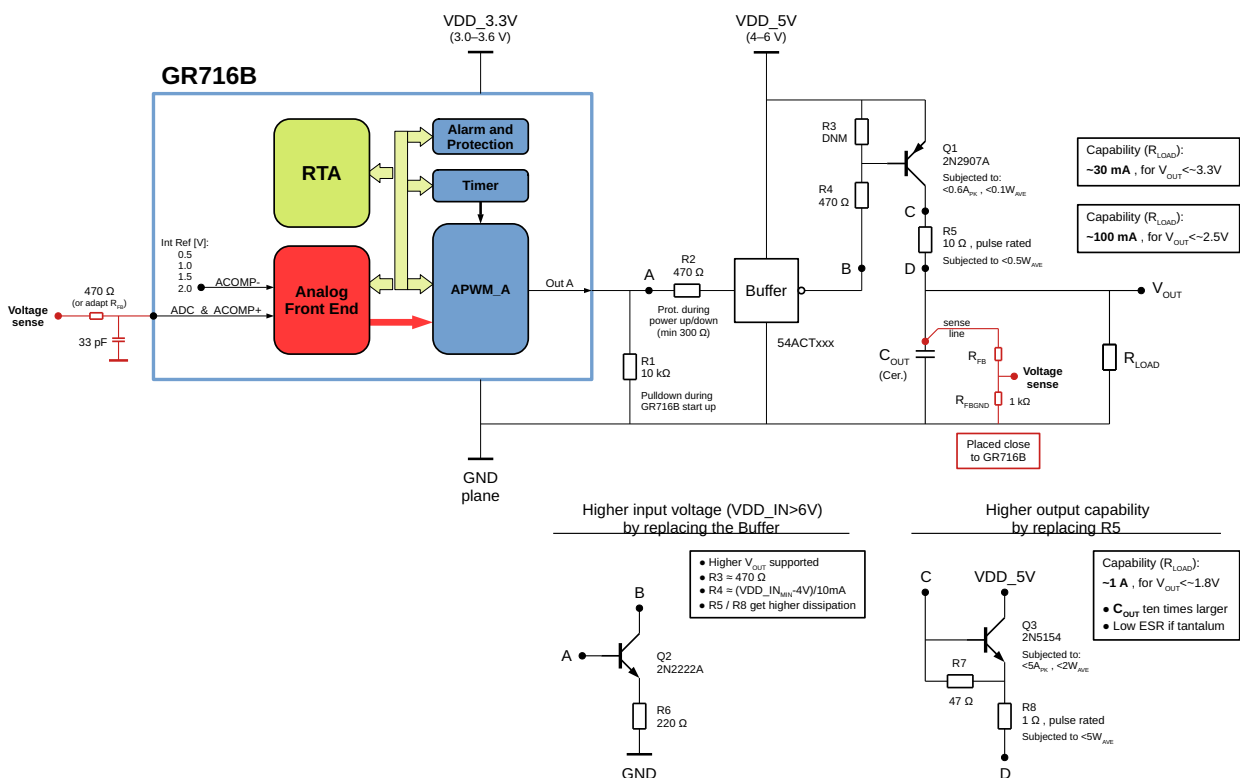


Figure 118. Simplified application schematic of a low-power DC/DC converter controlled by APWM\_A. Component types and values only illustrate topology functionality, and parts stress and worst-case corner performance are to be guaranteed by your detailed circuit analyses.

Time slot configuration in the APWM Timer is set to one slot, i.e., only slot 0 exists, since there is only one output voltage to be regulated by this APWM\_A block. Alternatively, if other APWM\_A blocks need this APWM Timer to be configured for more than one time slot, the APWM\_A in this example will simply be configured to have all its time slots enabled for operation.

The APWM\_A Out signal turns the power switch, Q1, on at APWM Timer equal to zero. This switching can cause disturbance transients on the output voltage and the feedback signal, 'Voltage sense', which could cause ACOMP to falsely turn off the duty cycle immediately. Therefore, it is advisable to configure adequate leading-edge blanking (LEB) time, and maybe implement a low-pass RC link on the ACOMP input pin, compatible with the ACOMP LEB ground switch. A source resistance in the order of 1kΩ and a capacitance of 33pF would be suitable together with LEB mode 1, and a realistic

# LEON3FT Microcontroller

LEB time may be 100-300 ns. At least 50ns is advisable, to ensure that ACOMP configured to fast mode has enough time to go low during the LEB time.

After Q1 has turned on, current is fed into the large output capacitor,  $C_{OUT}$ , and the output voltage,  $V_{OUT}$ , starts to increase. When the output voltage reaches the trig level of ACOMP, the duty cycle ends and the power switch turns off. There is no inductance with stored energy in this converter, so the output voltage stops to increase instantly at the end of the duty cycle. Thus, the positive-peak output voltage,  $V_{POS,PK}$ , never goes higher than the ACOMP trig level,  $V_{TRIG}$ , except for the switch turn-off delay in the PCB implementation.

The negative-peak output voltage,  $V_{NEG,PK}$ , is designed by the value of the output capacitor,  $C_{OUT}$ , together with the load current,  $I_{LOAD}$ , and the PWM period time,  $T_{PWM}$ . The worst (lowest) negative-peak output voltage will be:

$$V_{NEG,PK,min} = V_{POS,PK,min} - V_{DROP,max} = V_{TRIG,min} - I_{LOAD,max} * T_{PWM,max} / C_{OUT,min}$$

For this equation to be applicable, the current through the switch must be higher than the maximum allowed load current. Otherwise, the output voltage would continue to decrease even when the switch is turned on with 100% duty cycle. The current through the switch is designed by the value of the series resistor, R5. Here, also the maximum saturation voltage across Q1 needs to be taken into account. This current should be designed high enough with adequate margin to handle specified load current transients, spread of input supply voltage,  $VDD\_IN$  ( $VDD\_5V$ ), and all component tolerances. This current calculation gives the maximum allowed limit for R5.

The minimum allowed limit for R5, which will set the maximum instant current through R5 and Q1, will be limited by the maximum rating of pulse current for the resistor, R5, and the switch, Q1. The maximum instant current occurs during start up of this converter from zero output voltage. From the very first switching cycle at start up, the whole input supply voltage,  $VDD\_IN$  ( $VDD\_5V$ ), can be across R5, so the pulse current can be maximum:  $I_{max} = VDD\_IN_{max} / R5_{min}$ . Both R5 and Q1 must withstand this pulse current, and the resulting pulse power dissipation, throughout the start-up ramp on the output voltage,  $V_{OUT}$ . Therefore, pulse rating must be specified in the datasheet for the selected resistor type, and the absolute maximum limit for current should not be exceeded for the transistor.

The maximum voltage drop,  $V_{DROP,max} = I_{LOAD,max} * T_{PWM,max} / C_{OUT,min}$ , from the equation above, will be the output peak-to-peak triangular voltage ripple, and sets the required minimum output capacitance,  $C_{OUT,min}$ . For example, maximum allowed ripple of 30mV<sub>PK-PK</sub>, maximum load current of 100mA, and PWM period of 10us give minimum output capacitance of 33uF. Hence, for example, 47uF<sub>nom</sub> could be suitable to provide adequate margin for tolerances and load transients, but it depends on your application situation.

To get higher output current capability than R5=10Ω and Q1 (2N2907A, 0.6A rating) provide, R5 can be replaced by R7=47ohm, R8=1Ω and Q3 (2N5154, 5A rating) in the C and D connection points. This solution may provide about 1A output current, but it depends on the required output voltage level compared to the available input voltage level. Another way to get higher output current capability is to put more than one block of R3, R4, R5 and Q1 in parallel, in the connection points B and D. Each block needs its own R4=470Ω and R5=10Ω, to ensure equal current sharing. If more than three such blocks would be put in parallel, more than one 54ACT Buffer output is needed.

Alternatively, R5 can be changed to 1Ω and Q1 (2N2907A) changed to Q1=2N5153 (5A rating), with base drive from Q2 (2N2222A) and R6=39Ω, R3=100Ω and R4=-( $VDD\_IN_{min}$ -4V)/50mA (note that R4=0 for  $VDD\_5V$ ). This design may provide about 1A output current, and the dissipation and current properties stated for Q3 and R8 in figure 118 become applicable for the new Q1 and R5. For higher input voltage (see below), the choice of R4 can significantly affect the power dissipation in Q2, where higher R4 value will decrease Q2 dissipation. Anyhow, if the parts stress analysis shows that Q2=2N5154 is required, the Q3=2N5154 solution to get higher output current capability would be advisable instead of this whole Q1=2N5153 solution.

To handle higher input voltage,  $VDD\_IN$ , than a  $VDD\_5V$  supply bus, the Buffer can be replaced by R6 and Q2 (2N2222A) in the A and B connection points. The maximum input voltage will be limited by the collector voltage rating,  $V_{CEO}$ , for Q1 and Q2. A benefit with higher input voltage is that the

output voltage can be designed equally much higher as the increase of the minimum limit of input voltage. A drawback with higher input voltage is that the power dissipation in the converter itself can increase, especially in R5, R4 and Q2, due to increased voltage drop across them.

When significantly lower output current capability is required than provided by Q1=2N2907A, then Q1 can be by-passed. Q1, R3 and R4 are removed, and a (schottky) diode is inserted from point B to C. The converter output current is driven directly from the 54ACTxxx buffer output, and the buffer needs to have opposite signal polarity. To not overstress the buffer, R5 needs to have roughly an order of magnitude higher value, which will limit the output current capability to an order of magnitude lower than with Q1=2N2907A.

Support for PWM pulse skipping may be required in some application cases. Such a case is when the minimum duty cycle, due to necessary LEB time, is too long for the minimum load current in the application. This will cause a runaway overvoltage on the converter output, unless PWM pulses are skipped, i.e., not turned on at all when the ACOMP indicates high already at the start of the PWM cycle. A straightforward way to implement pulse skipping is to generate the PWM control signal in an APWM\_G block instead of using the APWM\_A Out signal, and the APWM\_G Out signal becomes the new PWM control signal. The APWM\_A State signal and ACOMP signal should be combined, where a simple logic definition for APWM\_G Out is:  $StateA \text{ and } not(ACOMP)$ .

A more advanced configuration, which ensures that the APWM\_G Out signal cannot toggle multiple times during the LEB time, is to use the set/reset flip-flop (SR-FF) configuration in APWM\_G, see the SR-FF example in section 53.5. Here, the set-condition should be:  $StateA \text{ and } not(ACOMP)$ . The reset-condition should be:  $StateA$ . These conditions ensure the SR-FF to be reset-dominant on StateA low level.

It is essential, whenever pulse skipping operation is based on ACOMP, that the ACOMP input pin represents the output voltage,  $V_{OUT}$ , at all times when StateA is high (actually from about 50ns before StateA goes high). Therefore, during this whole time interval, until the pulse-skipping decision is made, the ACOMP pin must not be disturbed by any PCB disturbance or on-chip activity such as ADC track or LEB activity. An LEB setting of about 100-300 ns, mode 0, can work well.

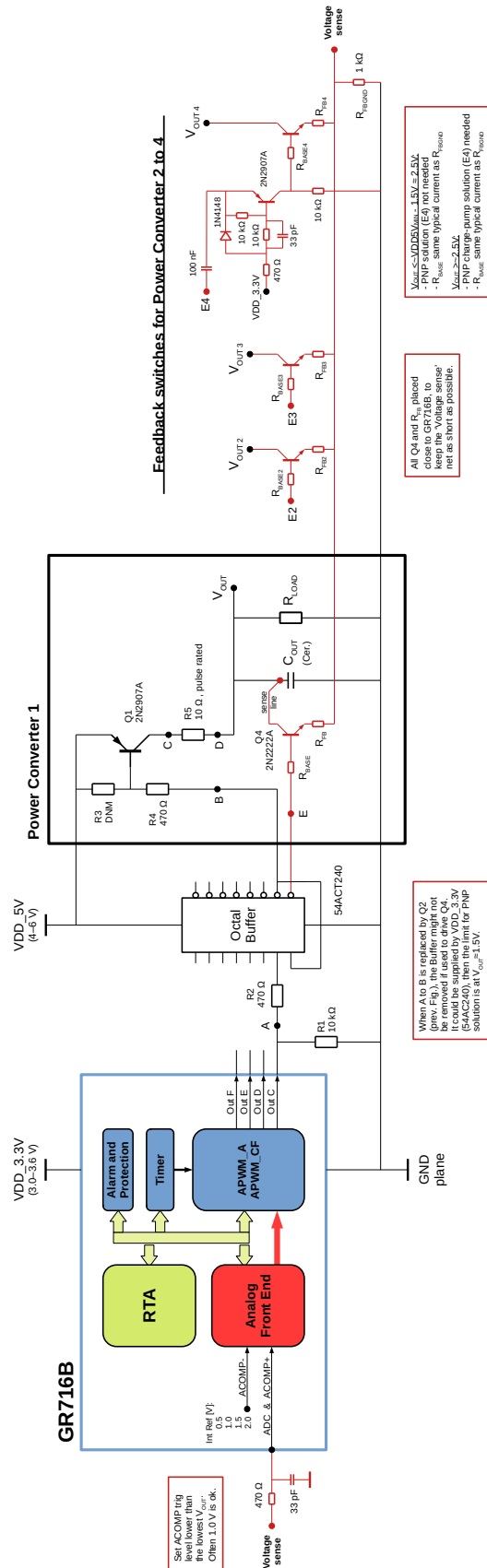
Regarding ground connections for the load and GR716B, the orders of current in this type of converter will not cause any problem with one and the same PCB ground plane used to both the load and GR716B. Note that the ACOMP internal reference in figure 118 (0.5, 1.0, 1.5, 2.0 V) has ground reference from GND (pin 75 is closest) for GPIO 51-58, and from  $V_{SSA\_REF}$  (pin 33) for GPIO 37-44. This reference grounding works well when the same PCB ground plane is used to both the load and GR716B, for the moderate orders of current here. However, in application cases where the total PCB ground current to and around the load is in the order of 10A or higher, the ground voltage drop between the load and GND/ $V_{SSA\_REF}$  can become too large, making the internal reference not valid to use as ACOMP trig level. In these cases, either an external difference amplifier can replace  $R_{FB}$  and  $R_{FBGND}$  and generate the 'Voltage sense' signal to the ACOMP input, or an external reference based on the local ground potential at the load can provide the trig level to the ACOMP minus input pin.

### 53.19.3 APWM\_A application: A controller for multiple DC/DC converters

A controller for multiple low-power DC/DC converters is presented here, see figure 119. It is based on one APWM\_A and four APWM\_CF blocks to regulate four independent output voltages. This type of controller can be useful in application cases where the number of ACOMPs in GR716B is a limited resource, at the same time as lower load-current capacity than in section 53.19.2 can fulfill the requirements.

*General note:* Component types and values in schematics should be interpreted as recommendations of right order of magnitude, presented to illustrate the functionality of the circuit topologies. They do not guarantee performance in worst-case corners, which needs to be guaranteed by detailed parts

stress and worst case analyses based on your exact component types and values including tolerances and all other electrical properties in your designs.



# LEON3FT Microcontroller

Figure 119. Simplified application schematic of four low-power DC/DC converters controlled by one APWM\_A and four APWM\_CF blocks. Parts stress and worst-case corner performance are to be guaranteed by your detailed circuit analyses.

Time slot configuration is set to 8 slots in the APWM\_A Timer and the APWM\_CF Timer, i.e., slot 0 to 7 exist. It is critical that both these Timers are configured identically, including their input Tick control from the same Main Timer, see figure 107. In this example, one output voltage uses every second slot, one uses two slots, and the last two outputs use one slot each, see figure 120. For configuration of APWM\_CF, see section 53.4.

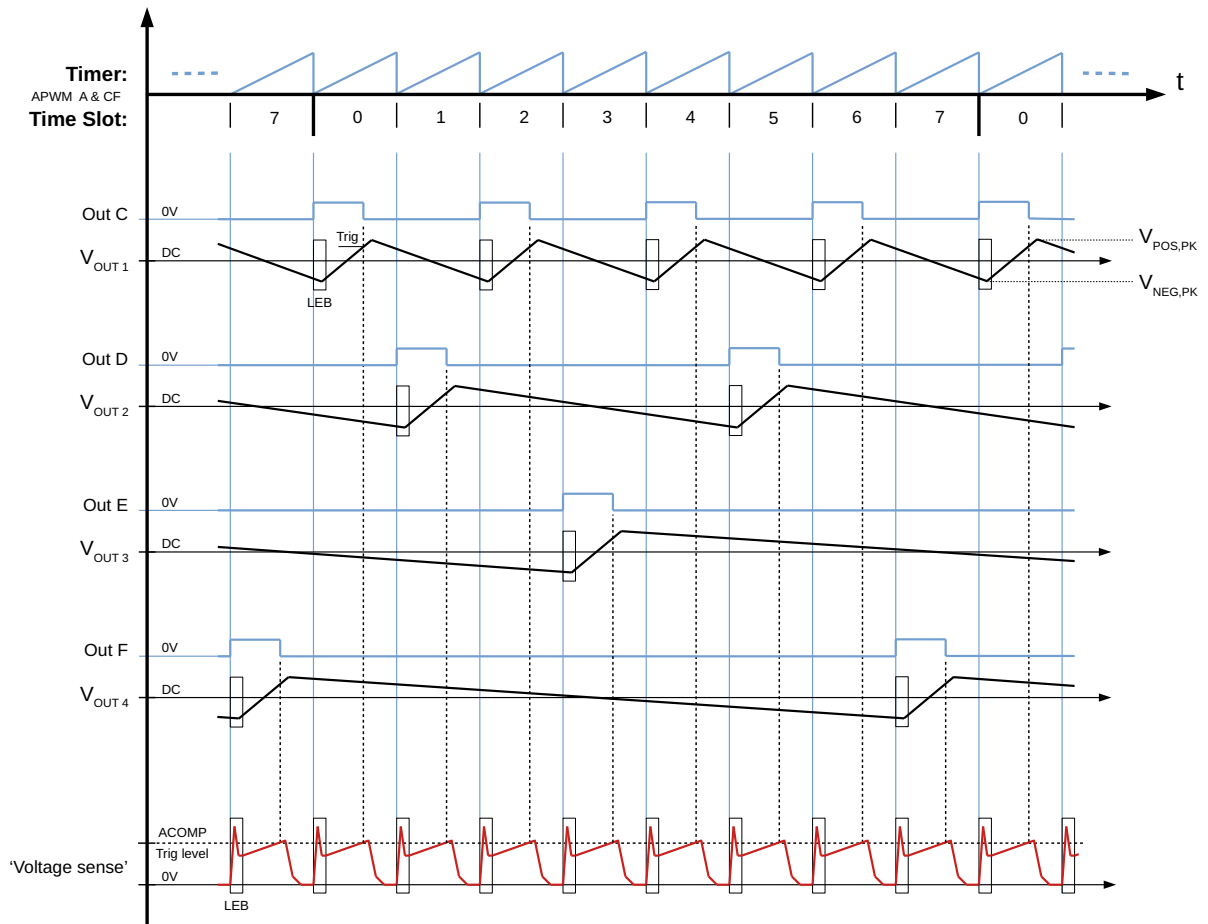


Figure 120. Timing diagram of a multi-converter controller for four output voltages.

At the start of each time slot, at APWM Timer equal to zero, the APWM\_A State signal goes high. Precisely one of the APWM\_CF blocks is configured to be active in each time slot, and the State signal for this APWM\_CF goes high simultaneously with the APWM\_A State signal. Thus, the power switch, Q1, for this APWM\_CF block turns on at this time point, since the ON Delay block should not give any delay in this kind of application.

In the first time slot in figure 120, Out C turns on and connects its feedback signal to the ACOMP input, see the red signal paths in figure 119. The output voltage,  $V_{OUT}$ , for this converter starts to increase. When it reaches the ACOMP trigger level, the APWM\_A State signal goes low, which is configured to end the duty cycle in APWM\_CF. Thus, Out C goes low and turns off its power switch. After this slot ends, Out D turns on and connects its feedback signal to the ACOMP input. This output voltage starts to increase, and when it reaches the ACOMP trigger level the APWM\_A ends the duty cycle so Out D goes low and turns off its power switch. In each of the 8 time slots, the ACOMP controls the duty cycle in the active APWM\_CF block in the same way. When the last time slot (7) has been executed, the sequence restarts immediately in the first time slot (0) again.

# LEON3FT Microcontroller

Regarding LEB settings, the LEB time should cover the turn-on delay of the feedback switches including settling of ACOMP, and the power-switch turn-on transients. They may require an effective LEB time of about 100-300 ns, e.g., LEB time configuration of 100ns, mode 1, and up to 200ns for accurate RC settling. However, it depends strongly on the detailed design of the switches. Any turn-off delay in the feedback switch in the previous time slot should be finished and settled in off state before that time slot ends, or at the latest it could continue partly into the LEB time of the next slot. Therefore, the duty cycle in each slot must be unconditionally terminated at a latest time point, preferably ensured by 'Duty Max Limit' configuration in each APWM\_CF block. Otherwise, the feedback signal in the next slot would become corrupted.

The output current capability for each output voltage will be according to the single-converter case above, but linearly decreased to be proportional to the number of time slots used for each output. So if all 8 slots would be used for one output, the capability is equal to the single-converter case, but the multiple APWM\_CF concept would obviously be pointless. If half of the slots are used for one output, like for  $V_{OUT1}$  in figure 120, the current capability becomes 1/2. If 1/8 of the slots is used, like for  $V_{OUT3}$  and  $V_{OUT4}$ , the current capability becomes 1/8. Regarding the converter internal power dissipations, the average dissipations from cooling point of view will be reduced by the same slot factors. However, the pulse/peak stresses in the components will stay the same as in the single-output case.

To get higher current capability for a converter output, the same solutions as presented for the single-converter case can be used (i.e., Q3=2N5154, Q1=2N5153 and power-switch blocks put in parallel). Here too, the average dissipations are reduced by the same slot factors, but the component pulse/peak stresses are not reduced.

To handle higher input voltage, the same solution as in figure 118 can be used, which is based on Q2 and R6 instead of the Buffer. However, also the feedback-switch control signal (connection point E), needs to be generated with equally higher voltage swing, which should be between ground and the new higher input voltage,  $VDD_{IN} > 6V$ . This control signal can be generated by implementing a copy of the power-switch block, point B to C, i.e., R4, R3 and Q1. And a pulldown resistor to ground needs to be added in point C. Point B of the new block is connected to point B in the existing circuit. Thus, the same Q2 collector drives point B of both the existing and new block. The new point C will drive the feedback-switch control signal, i.e., point E.

Let these new components be called Q1', R3', R4' and  $R_{PD}$ . The values will primarily affect the switching time, which may require a certain LEB time to be configured in APWM\_A, which in turn will be a limiting factor for minimum PWM period time. In general, keep in mind that a longer PWM period time will require larger output capacitor,  $C_{OUT}$ , in a converter. A reasonable target could be to keep LEB within about 300 ns (including settling of ACOMP pin), where the following values may be the right order of magnitude: Q1'=2N2907A, R3'=1k $\Omega$  and R4'= $\sim(VDD_{IN_{min}}-4V)/1.5mA$ ,  $R_{PD}=\sim VDD_{IN_{typ}}/3mA$ .

PWM pulse skipping is not as easy to support as in the single-output APWM\_A case, because the ACOMP is not connected to one and the same output voltage all the time. It can be viewed as it is 'disturbed' when connected to the other output voltages during all the other time slots, and can only be trusted in the dedicated time slot. Based on this time-slot limitation, one straightforward way to introduce pulse skipping can be to let the feedback-switch turn on as fast as possible when the APWM\_CF Out signal goes high, whereas an intentional delay is introduced on PCB to the power switch. After the feedback switch and ACOMP have settled accurately, but before the power switch turns on, the LEB in APWM\_A should end. A realistic LEB configuration may be in the range 100-300 ns, mode 0, but it depends on the feedback-switch design.

The intentional power-switch delay needs to be longer than the LEB time, to ensure that the ACOMP can end the duty cycle before the power-switch transistor turns on, in the cases the PWM pulse should be skipped. If the power-switch delay in worst-case corner would become slightly too short, turning on slightly before LEB ends, the consequence is that the pulse skipping function is not ideal, i.e., a minimum load current will still be required, but can be significantly lower than without any intentional power-switch delay at all.



# LEON3FT Microcontroller

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A drawback with this simple delay solution is that there is no effective LEB function during the turn-on transients from the power switch, since this switch is intentionally delayed till after the LEB time has ended. Therefore, it is especially important to handle the whole sense signal path, all the way from  $C_{OUT}$  pin (long layout wire), through the feedback switch (placed close to GR716B), and through the low-pass RC link, with great care in the PCB layout design. To get slower and lower turn-on transients, it might also be beneficial to introduce a low-pass capacitor across base-emitter of the power switch, Q1. This capacitor could also constitute the intentional delay of the power switch, provided that the delay accuracy will be good enough.

In case proper LEB function is desired throughout the power-switch transients, the power-switch control can be implemented by a set/reset flip-flop (SR-FF) configured in an APWM\_G block, see the SR-FF example in section 53.5. The reset-condition should be the State signal from 'duty-APWM\_CF', defined here to be the APWM\_CF block controlled by the APWM\_A according to above. The SR-FF should be configured to be reset-dominant, i.e., this reset-condition should be configured into both APWM\_G words. The set-condition should be 'set-APWM\_CF' and *not*(ACOMP), where this new APWM\_CF block shall turn on after accurate ACOMP settling (after 100-300 ns), and stay high a couple of system clock cycles. In case more than one of the converters need pulse skipping, the State signal from 'set-APWM\_CF' can be re-used to all those APWM\_G blocks, and should generate such a pulse in all time slots.

If ACOMP is high during the 'set-APWM\_CF' system clock cycles, the output voltage is above the regulation level already at the start of the PWM cycle, and this PWM cycle will be skipped (the SR-FF will not be set). If ACOMP is low during these cycles, the PWM duty cycle is started and the power switch turns on. It stays on until ACOMP reaches its trig level, or until the duty cycle reaches the configured 'Duty Max Limit' in 'duty-APWM\_CF'. After that, the 'duty-APWM\_CF' stays low (the feedback switch stays off), and thereby the SR-FF stays low (the power switch stays off), until the next active time slot.

It is essential that the low-pass RC link and ACOMP has settled accurately, for at least 4 RC time constants after the feedback switch is turned on, before 'set-APWM\_CF' turns on (100-300 ns). Otherwise, ACOMP can make the wrong decision for pulse skipping. The LEB setting in APWM\_A should be long enough to cover the feedback-switch settling (maybe 100-300 ns) plus the following power-switch settling (maybe another 100-300 ns), which in this example gives an LEB configuration in the range 200-600 ns, mode 0. However, this configuration will be strongly dependent on all the switch designs.

The benefits with this SR-FF solution are accurate delay control, and LEB function provided throughout the whole feedback-switch and power-switch turn-on time, which maintains a robust controller functionality also in strongly disturbed circuit board environments. The drawback is the additional APWM\_G block and GPIO pin per converter.

Regarding ground connections for these loads in relation to the GR716B ground connection, the same comments are valid as for the single-converter case above. One and the same PCB ground plane can be used to the loads and GR716B, for the orders of current in these converters. But if the total PCB ground currents are in the order of 10A or higher, special care needs to be taken for design of the 'Voltage sense' signal. When this design is based on external difference amplifier(s), it can be one op-amp per output voltage, generating each signal going to the Q4 collector; or, it can be one common op-amp, generating the 'Voltage sense' signal. A drawback with one common op-amp is that it can only sense one common ground point for all the converters. Moreover, it needs to be fast (slewrate plus exponential settling within a couple of hundred nanoseconds) to provide accurate settling before the LEB time ends. It might actually be likely that the design with one op-amp per output voltage, in addition to making the design work more straightforward with easy individual ground points and no need for critical settling-time verifications, also will reduce op-amp cost, since these can be low-performance general op-amps.

**53.19.4 APWM\_CF application: DC/DC converter example (PSFB)**

A phase-shifted full-bridge DC/DC converter (PSFB) is an application where APWM\_CF blocks are suitable to use, see figure 121. This converter also uses APWM\_AB and APWM\_G, see section 53.5.

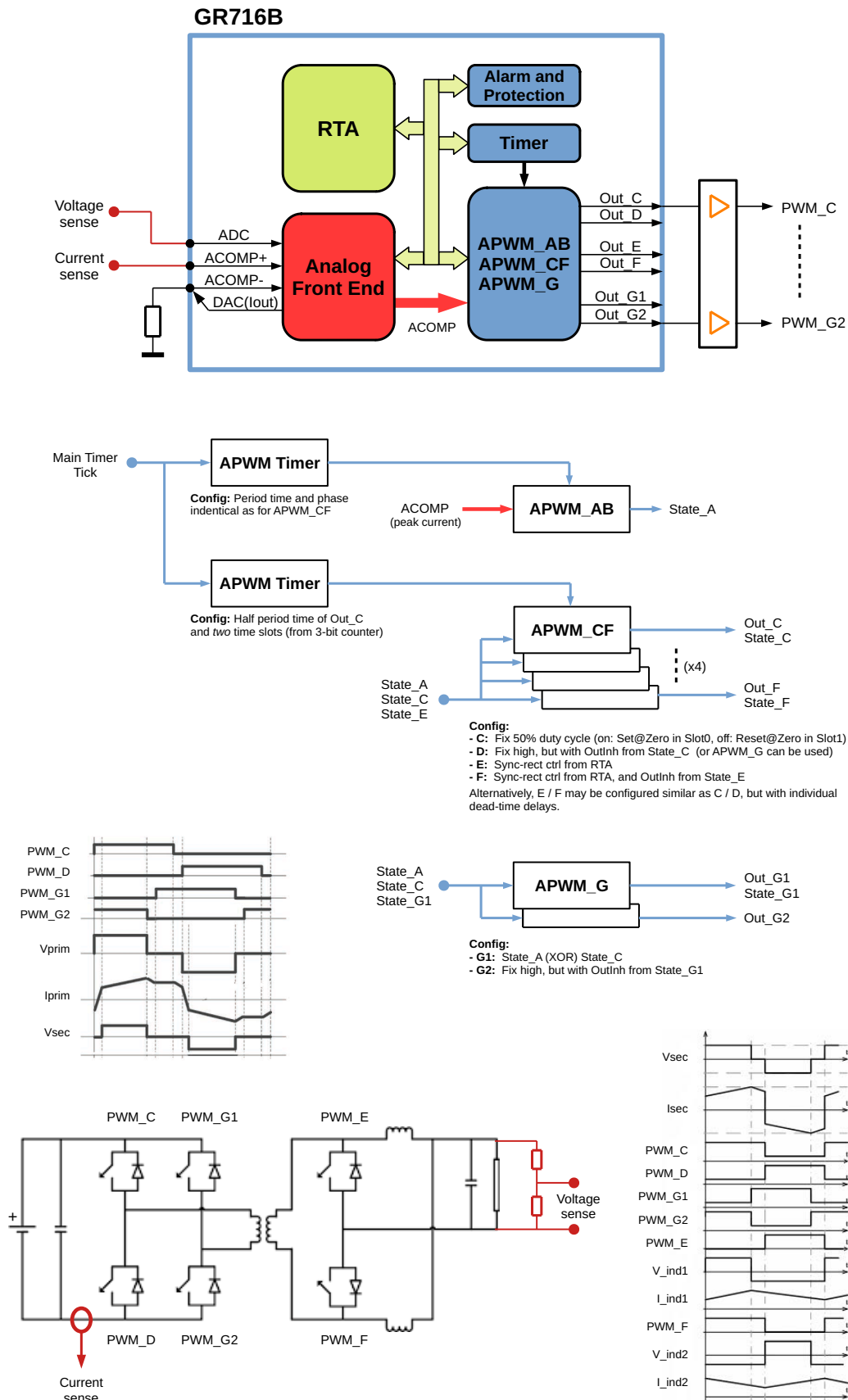


Figure 121. Configuration example for a phase-shifted full-bridge DC/DC converter (PSFB). The left time diagram shows primary-side signals with dead-time delays. The right time diagram shows secondary-side signals with synchronous rectification.

# LEON3FT Microcontroller

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Peak-current control is performed by APWM\_AB, where the current can be measured by one sense resistor in the primary ground line. The current-sense voltage goes into the on-chip analog comparator that provides the ACOMP signal to APWM\_AB. The current-sense voltage can also be A/D converted and made available to RTA for monitoring purposes.

Each switch pair in the full-bridge is a half-bridge, where it is critical to apply well-controlled dead time to avoid destructive switching transients. This is first described for APWM\_AB, see section 53.2. In general, the view points in that section, how to switch voltages and currents in a half-bridge, are applicable also for PSFB half-bridges. But specifically for PSFB converters, it can be beneficial to apply zero-voltage switching by dynamic control of dead times. This is straightforward to implement in RTA software since it has direct access to the ON Delay settings.

In a PSFB converter, the switching in each primary-side half-bridge is always 50% duty cycle in both half-bridges. A converter duty cycle starts when PWM\_C turns on, and when PWM\_C turns off; that is, there are two cycles of peak-current control per PWM\_C/D period. Control of the converter duty cycle is done by phase shifting (delaying) the PWM\_G1/G2 switch time points in relation to the PWM\_C/D switch time points. This is controlled by APWM\_AB peak-current control twice per PWM\_C/D period.

When this delay is zero (PWM\_G1/G2 is in-phase with PWM\_C/D), the converter duty cycle is zero, and no power is transferred to the converter output. When this delay is half a PWM\_C/D period (PWM\_G1/G2 is 180° delayed to PWM\_C/D), the converter duty cycle is maximum, and maximum power is transferred to the converter output.

The desired converter duty cycle, to maintain the desired converter output voltage, is controlled by RTA software together with the APWM\_AB peak-current control. Each APWM\_AB cycle, the RTA reads the output voltage, executes the control law, and writes a new reference level to the DAC for peak-current control in APWM\_AB. This control loop will regulate the output voltage to a predefined DC level set in the RTA software. Further details how to control a PSFB converter with synchronous rectification are referred to textbook literature.

### 53.19.5 APWM\_CF application: Motor control example

A standard 3-phase brushless DC motor (BLDC) can be PWM controlled by 3 APWM\_CF blocks combined with 3 APWM\_G blocks, see figure 122. There are several schemes for control and commutation of the motor windings such as trapezoidal (often for BLDC), sinusoidal (often for PMSM), and field-oriented control (FOC). Any such scheme is supported by APWM\_CF running in stand-alone mode, since Timer and Duty control can be updated PWM cycle-by-cycle from RTA.

# LEON3FT Microcontroller

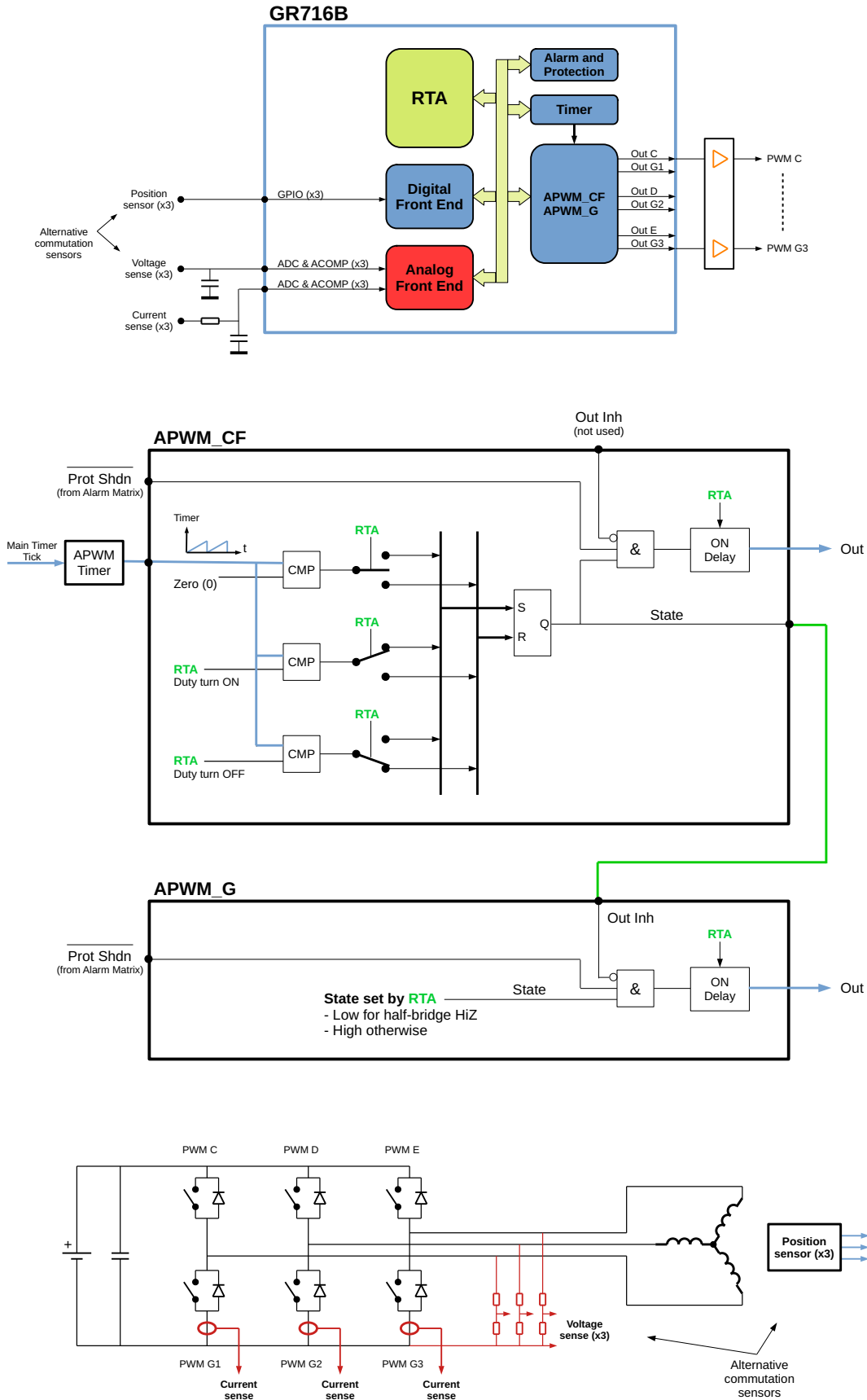


Figure 122. 3-phase BLDC motor application.

# LEON3FT Microcontroller

The top switch in each half-bridge is connected to an APWM\_CF block, controlling the PWM function and the commutation timing, see switches PWM C/D/E in figure 122. Each bottom switch is controlled by an APWM\_G block (or another APWM\_CF), and provides interlock and dead-time against its top switch. If desired, these interlock and (fixed) dead-time functions are straightforward to implement in hardware on PCB instead, making these APWM\_G blocks free for other usage.

Trapezoidal commutation is a basic and commonly used commutation scheme for 3-phase BLDC motors, see the example in figure 123. The motor windings are energized in a 6-step pattern every 60° electrical degree so that one phase is on (high), another phase is off (low), and the last phase remains unconnected (high impedance), which produces a 120° trapezoidal-shaped current waveform. The duty cycle of the PWM signal sets the motor winding current, and is controlled by the RTA based on winding currents measured by ADC. This 6-step pattern makes the motor rotate in one direction, and exchanging the patterns for two of the windings will reverse the rotation direction.

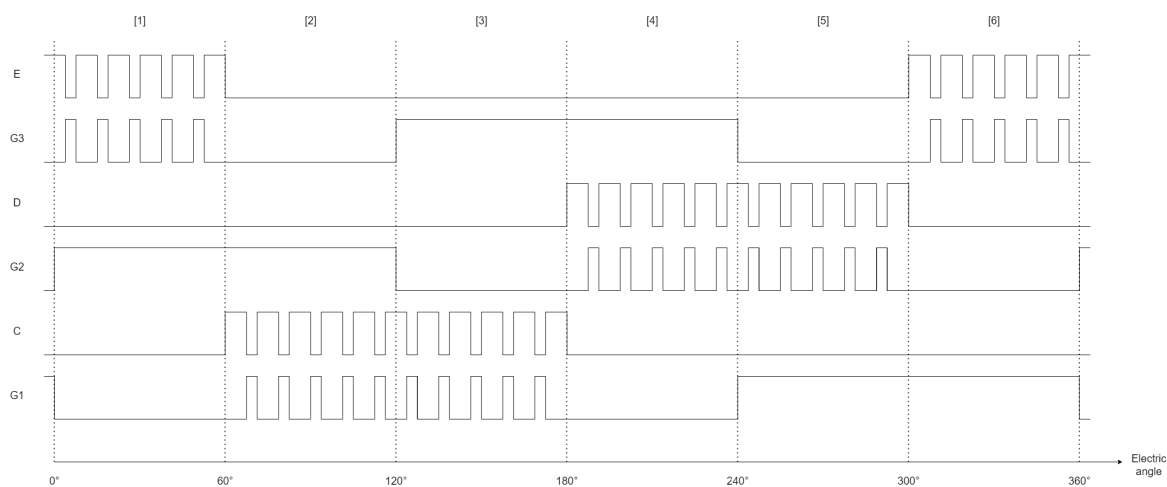


Figure 123. Bridge drive scheme for PWM controlled 3-phase BLDC motor with trapezoidal commutation.

Commutation time points depend on the motor position and can be detected by sensors, e.g., halleffect sensors, encoders, resolvers, or by voltage detection on motor windings by ACOMP level triggering or ADC measurement. A wide variety of different sensor and encoder signals can be received by GPIOs, including accurate timestamp information if needed.

Winding current measurements can be done across a sense resistor to ground during the low time in each half-bridge PWM cycle. A prerequisite is that the duty cycle does not go all the way up to 100% (the low-side switch must be on a couple of percent each PWM cycle). The accurate ADC sampling control in GR716B, provided for DC/DC converter current measurements, hence, is useful also here for motor current measurements. Furthermore, if desired, overcurrent detection can be configured as an ACOMP voltage trig level on the same sense resistor.

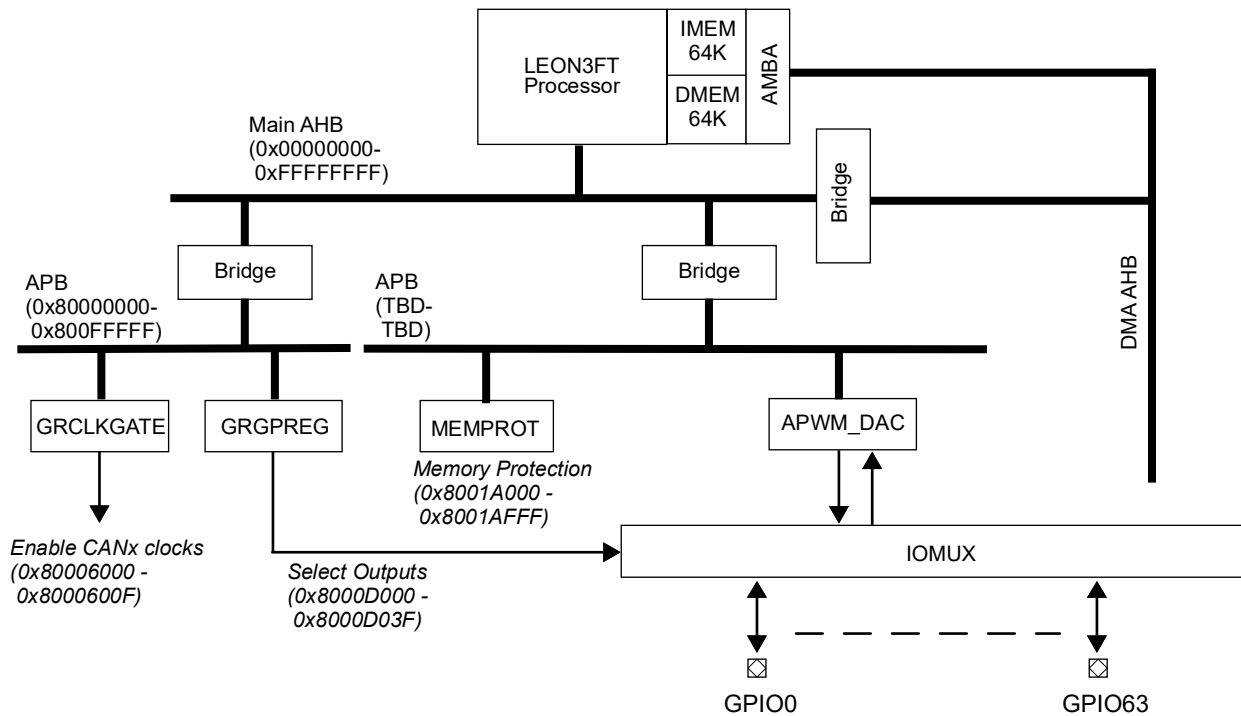
# LEON3FT Microcontroller

## 54 Digital Modulator for Analog Precision DAC Outputs (APWM\_DAC)

The GR716B microcontroller contains four Analog Precision Digital Modulator units (APWM\_DAC). The APWM\_DAC unit controls its own external pins and has a unique AMBA address described in chapter 2.10.

The APWM\_DAC units are located on APB bus in the address range from 0x81009000 to 0x8100C0FF. See APWM\_DAC unit connections in figure 124, showing memory locations and functions for configuration and control.

Figure 124. GR716B APWM\_DAC bus and pin connection



The secondary clock gating unit **GRCLKGATE** described in section 28 is used to enable/disable the APWM\_DAC units. The unit **GRCLKGATE** can also be used to perform reset of the APWM\_DAC units. Software must enable clock and release reset described in section 28 before configuration and transmission can start.

The APWM\_DAC configuration and status registers are described in section 54.4. System can be configured to protect and restrict access to APWM\_DAC units in the **MEMPROT** unit. See section 47 for more information.

### 54.1 Overview

APWM\_DAC provides a digital modulated output signal, to be low-pass (LP) filtered on PCB. It can work as a second-order or two first-order delta sigma modulators, see figure 125. It can run on external clock from GPIO or internal clock configurable to system clock divided by an integer value. The modulator input value can be updated continuously from RTA or the main LEON3FT.

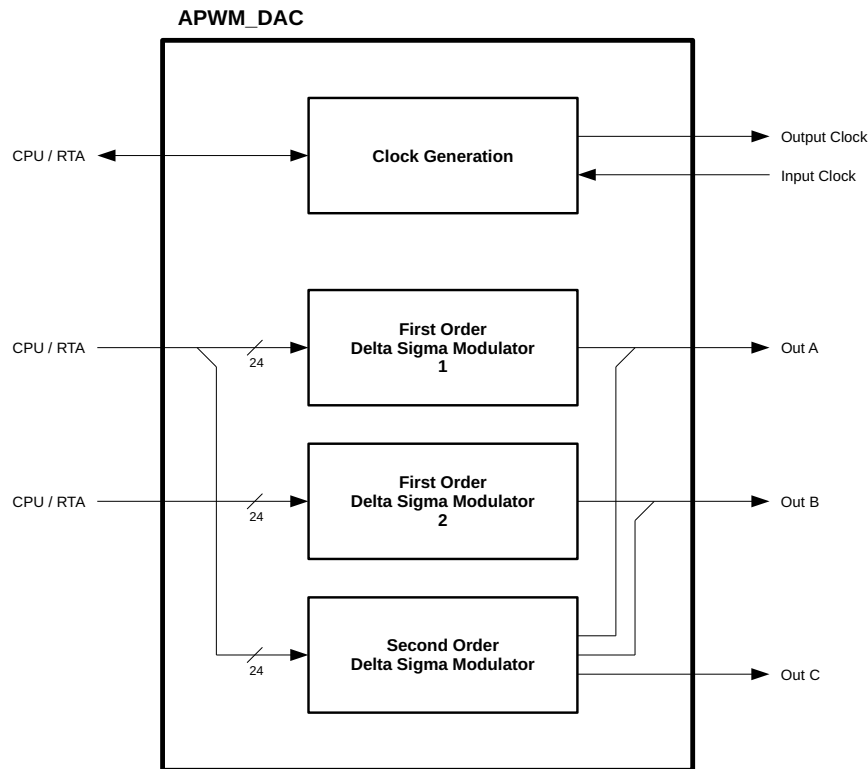


Figure 125. Block diagram of an APWM\_DAC unit

The analog precision after the LP-filtering has higher resolution than the 12-bit DAC in section 15. But the analog bandwidth is typically lower, e.g., in the range 0.1 to 100 kHz, depending on how the PCB LP-filter is optimized for analog bandwidth, ripple, filter complexity, etc.

## 54.2 Operation

APWM\_DAC output spectra are presented in figure 126, where it can be noted that the first-order modulator has a slope of about 20 dB/dec (at medium high frequencies), and the second-order modulator has about 40 dB/dec. Therefore, the first-order modulator requires a second-order LP-filter on PCB to suppress the high-frequency noise, whereas the second-order modulator requires a third-order filter.



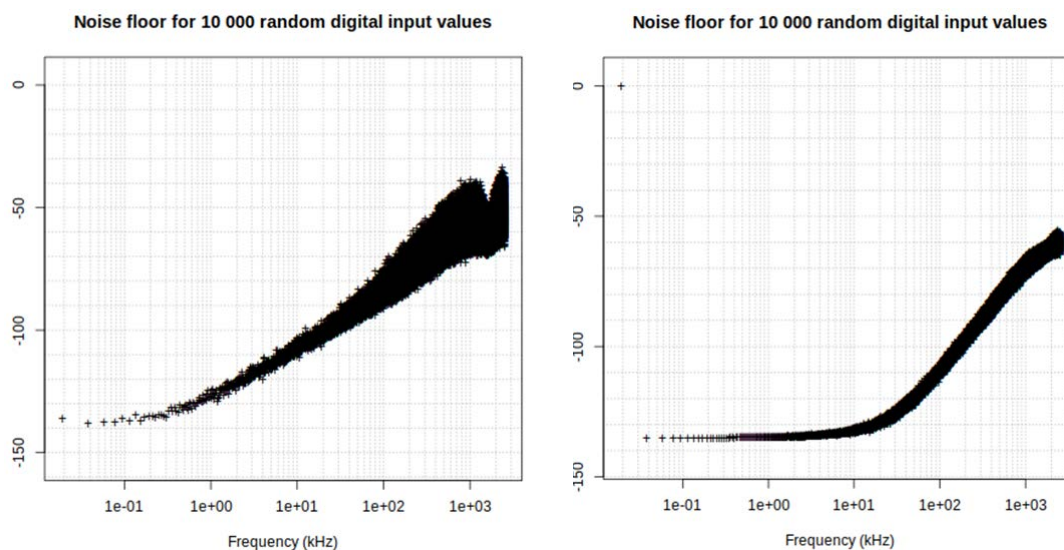


Figure 126. FFT simulation on the modulator digital output. Average over all input values is plotted per FFT frequency, and modulator clock frequency is 5 MHz. First-order modulator to the left and second-order modulator to the right.

The input digital value is a 24-bit unsigned integer. The output average value after LP filtering, for the first-order modulator, is between 0 and 1, and is linear to the input digital value. The output average value for the second-order modulator is between 1/3 and 2/3, linear to the input digital value, when the output is connected as the simplest three-resistor LP-filter in figure 127.

When the modulator runs on internal clock, this clock is available on GPIO output if desired. The frequency is configured by an integer divisor on the system clock, with a minimum divisor such that the modulator frequency is maximum 25 MHz. The modulator outputs are updated on negative output-clock edge, so if flip-flops are implemented on PCB, they should be clocked on the positive edge.

When the modulator runs on external clock from PCB, the positive edge of this input clock will act as modulator clock and update the modulator outputs. The positive edge should also be used to clock flip-flops on PCB, to provide maximum setup time to these flip-flops. Maximum propagation delay in GR716B, from positive input-clock edge on GPIO pin to modulator outputs on GPIO pin, is  $5\text{ns} + 1.6/f_{\text{intsys}}$ , which is maximum 21 ns at 100 MHz system clock (and add up to 5 ns for PCB load on GPIO output of up to 25 pF).

### 54.3 Application Examples of PCB Filters

In the simplest form, the LP-filter on PCB can be two cascaded RC-links directly connected to the modulator output GPIO pin on GR716B. Then, the  $V_{\text{DD\_IO}}$  supply on GR716B acts as reference/full-scale voltage for this analog output, see top left in figure 127 (“2nd-order low-pass filter”). If better accuracy is required, a CMOS buffer can be added on PCB, with VDD connected to a precision reference voltage, see mid schematic in figure 127 (“Precision reference, Output buffer”).

# LEON3FT Microcontroller

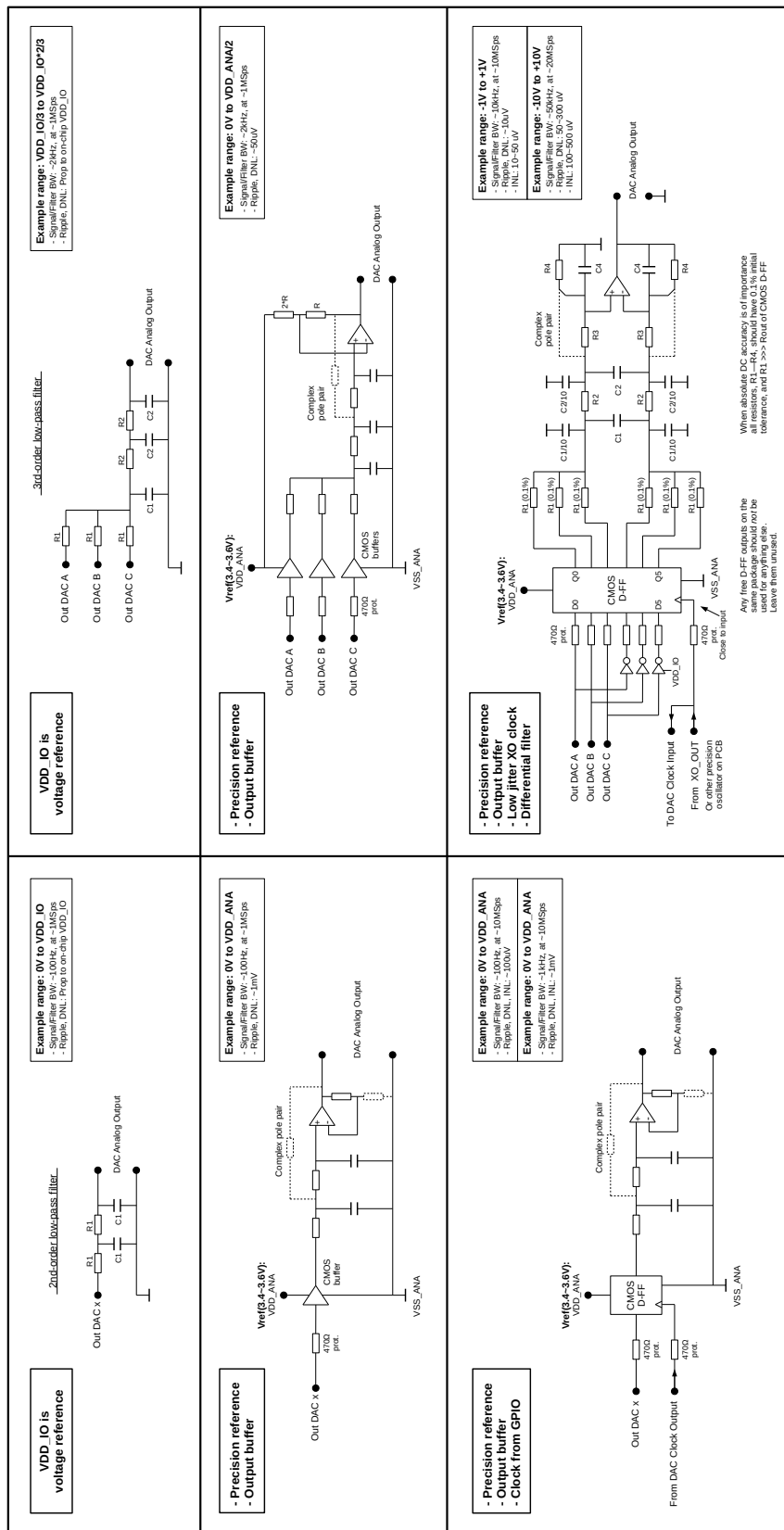


Figure 127. PCB LP-filter examples for APWM\_DAC. Higher PCB circuit complexity provides better analog performance. The performance numbers might be the expected order of magnitude, and are only provided here for understanding of each filter topology's properties in comparison to the other topologies.

# LEON3FT Microcontroller

The GR716B on-chip implementation supports 24-bit DAC resolution, meaning that it will be the PCB analog implementation that limits the analog output performance. Hence, the higher complexity and cost that is acceptable in the PCB implementation, the better analog accuracy, higher bandwidth, lower analog ripple, etc, can be achieved.

Excellent analog accuracy can be achieved by re-clocking the modulator output through a clocked CMOS register on PCB, with VDD connected to a *precision reference voltage* and clock from a *stable oscillator* such as a crystal oscillator, e.g., XO\_OUT on GR716B. And *balanced* signal generation would be recommended, fed into a *differential* op-amp-based LP-filter. Then, the CMOS register needs to generate both inverted and non-inverted outputs, see the last schematic in figure 127. Such an implementation might provide accuracy (INL) in the order of 100 uV, assuming fullscale range in the order of a couple of volts, but it will depend on many details in the PCB implementation, e.g., how the grounds are implemented in PCB layout and on system level.

When high analog bandwidth is desired, the second-order modulator with third-order LP-filter needs to be used, together with high modulator frequency. To maintain correct pulse-width duty cycle at high modulator frequency, balanced differential signal generation on PCB is highly beneficial. In the order of 100 kHz analog bandwidth or possibly up to 1 MHz might be feasible to achieve, with analog ripple in the order of 1 mV, at modulator frequency of about 20 MHz, but it depends on many details in the PCB implementation.

When high linearity is desired in second-order modulator mode, the linearity can be affected by mismatch between the three output averaging resistors (or six resistors in the last schematic). Resistors with 1% initial tolerance, which commonly have 2% to 3% total tolerance over full temperature, might be advisable for linear dynamic range up to the order of 80 dB (ENOB= $\sim$ 13 bits), or possibly a little bit higher. For linear dynamic range of about 100 dB (ENOB= $\sim$ 16 bits) or better, it is advisable to use resistors with 0.1% initial tolerance (0.2% to 0.3% total tolerance). Moreover, the order of impedance level for these resistors should be selected to about 1000 times higher than the output impedance of the CMOS buffers.

## 54.4 Registers

The APWM\_DAC unit is programmed through registers mapped into APB address space.

Table 686. APWM\_DAC registers

APB address offset	Register
0x81009000	APWM_DAC 1 Register 1 (TBD)
0x81009004	APWM_DAC 1 Register 2 (TBD)
0x81009008	APWM_DAC 1 Register 3 (TBD)
0x8100900C	APWM_DAC 1 Register 4 (TBD)
0x81009010	APWM_DAC 1 Register 5 (TBD)
0x81009014	APWM_DAC 1 Register 6 (TBD)
0x8100A000 - 0x8100A0FF <sup>1)</sup>	APWM_DAC 2
0x8100B000 - 0x8100B0FF <sup>1)</sup>	APWM_DAC 3
0x8100C000 - 0x8100C0FF <sup>1)</sup>	APWM_DAC 4

Note 1: APWM\_DAC 2, 3, and 4 have the same register as APWM\_DAC 1 with a different offset.

# LEON3FT Microcontroller

## 54.4.1 APWM\_DAC 0 registers

Table 687.0x00 - APWMDAC0STS - APWMDAC0STS Status register

31	0
TBD	
0	
r	

31: 0 To be defined

## 54.4.2 APWM\_DAC 1 registers

Table 688.0x00 - APWMDAC1STS - APWMDAC1STS Status register

31	0
TBD	
0	
r	

31: 0 To be defined

## 54.4.3 APWM\_DAC 2 registers

Table 689.0x00 - APWMDAC2STS - APWMDAC2STS Status register

31	30	28	27	26	25	24	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED																						
0																						
r																						

31: 0 Reserved

## 54.4.4 APWM\_DAC Clock Generator

Table 690.0x00 - APWMDACCLKSTS - APWMDACCLKSTS Status register

31	0
TBD	
0	
r	

31: 0 To be defined

# LEON3FT Microcontroller

## 55 FPGA Scrubber Controller

### 55.1 Overview

Devices in the space environment are vulnerable to radiation-induced particles, and SRAM-based FPGAs are particularly susceptible to Single Event Upsets (SEU) that may affect the configuration memory. Soft errors in the FPGA configuration memory can change the device functionality and lead to errors and malfunction in the system. The scrubbing method is essential to avoid an accumulation of upsets in the FPGA configuration memory.

The GRSCRUB is an external FPGA scrubber controller responsible for programming and monitoring the FPGA configuration memory. The GRSCRUB is compatible with the Kintex UltraScale and Virtex-5 Xilinx FPGA families. The scrubbing functionality can be set to target the entire FPGA configuration memory or just a defined memory area.

The scrubbing mitigation technique only fixes bit-flips in the FPGA configuration memory, being up to the user to apply any additional method to mask errors and re-establish the state of the system. Scrubbing does not cover soft-errors affecting User memory data. All dynamic data stored in memory elements, such as shift-registers (SRL), LUT RAMs, and Block RAMs (BRAM), are not verified by the GRSCRUB.

Figure 128 shows the system block diagram. The GRSCRUB accesses the FPGA configuration memory through the SelectMap interface. In addition, the GRSCRUB accesses through an AMBA AHB or AXI4 bus a Golden memory that can be ROM or RAM. The original configuration bitstream is stored in the Golden memory, and it is used both to configure the FPGA at start-up and to repair the FPGA configuration memory in case of errors. The Golden memory also stores the mask data and the Cyclic Redundancy Check (CRC) codes used to check the configuration bitstream integrity. If a ROM memory is used, all the required data must be previously stored, such as the frame addresses and CRC codes, as further described, since some functionalities of the GRSCRUB that writes on the memory will not be executed.

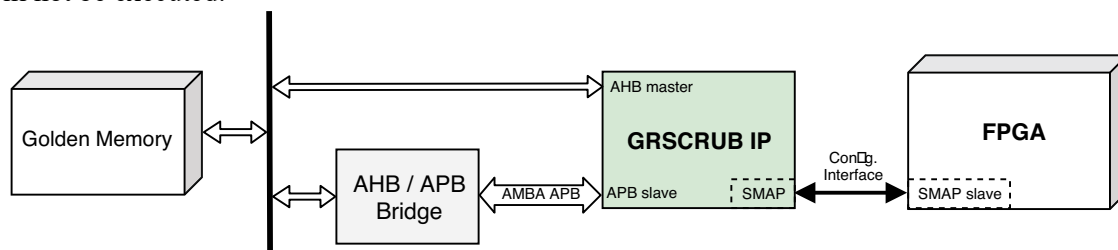


Figure 128. System block diagram

The SelectMap interface must be enabled in slave mode at the target FPGA to allow external control from the GRSCRUB. Figure 129 shows an example of the GRSCRUB and slave SelectMap connection in a Xilinx UltraScale FPGA. In the example, the GRSCRUB port signals are directly attached to the SelectMap pins. The system provides the SelectMap clock to the FPGA configuration interface (CCLK) and the GRSCRUB (SMAPCLKI). As further described, the GRSCRUB works in two clock domains, CLK that is the system clock, and SMAPCLKI that is the SelectMap clock used for synchronization. In addition, the GRSCRUB has a clock enable signal that controls whether the CCLK should be enabled or not. The FPGA mode pins M[2:0], which select the FPGA configuration interface used, must be configured to slave SelectMap. Thus, these pins must be connected to M[2:0] pins from the GRSCRUB or directly tied to high/low levels externally. For more details, see the documentation for the Xilinx FPGA family. Also, refer to the FPGA Data Sheet to define the proper voltage connection.

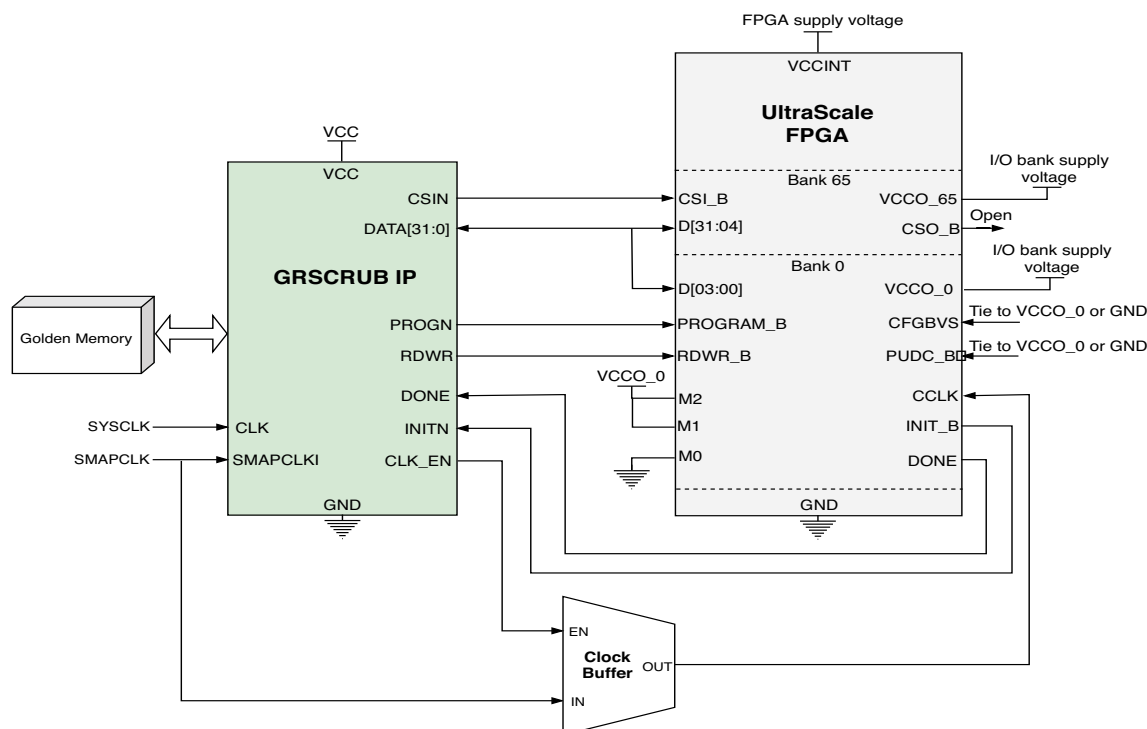


Figure 129. Example of GRSCRUB and slave SelectMap interface connection for Xilinx UltraScale FPGA

## 55.2 Soft error mitigation

Radiation-induced soft errors are errors provoked by radiation particles that affect the design without damaging the device permanently. SEUs, or bit-flips, in the FPGA configuration memory may lead to persistent errors in the system, changing the architectural implementation of the design. Soft errors can also affect the memory data, registers, and flip-flops, and cause errors in the system outputs. Single Events Transients (SET) are transient pulses that propagate through the combinational logic and may be captured by a memory cell. The Single Event Functional Interrupt (SEFI) occurs when a soft error affects the control logic or a state register and leads to hangs or crashes in the design.

The GRSCRUB targets soft errors affecting the FPGA configuration memory. It does not avoid bit-flips from happening or its effects on the design. The GRSCRUB aims to maintain the configuration memory consistent by repairing the logic and correcting bit-flips, avoiding the accumulation of faults. Memory elements that store dynamic data, such as BRAMs, distributed memory, and flip-flops, are not protected by the GRSCRUB. The scrubbing technique is able to verify only the static data in the configuration memory. The configuration memory stores the architectural logic information of a design and defines the function, behavior, and connectivity of each block. The GRSCRUB must be combined with additional fault mitigation methods at the user level to increase the overall system reliability.

Soft errors affecting the dynamic elements can be mitigated by applying fault tolerance techniques such as redundancy or Error Correction Code (ECC). Triplicating the logic is an efficient method to cope with the effects of single faults in the design. Additional user level techniques can also be applied to deal with Silent Data Corruptions (SDC) that are incorrect results outputs. Moreover, periodic reset may be required to reestablish the system state, and restore the initial state of flip-flops. Since SEFIs may also affect internal control elements of the FPGA or the configuration interface, a complete power cycle might be required to restore the system.

# LEON3FT Microcontroller

## 55.3 Operation

The GRSCRUB main operational modes are programming the FPGA and scrubbing the configuration memory correcting errors. Figure 130 describes the basic flow of these two operational modes (OPMODE). After system reset, the GRSCRUB remains in the idle state until the EN bit of the Configuration Mode Register (CONFIG) is set high. If the programming mode is selected, the GRSCRUB starts the configuration sequence to program the FPGA. At the end of the programming phase, the OPDONE bit of the Status Register (STATUS) is set high, and the GRSCRUB return to the idle state.

For the scrubbing operation mode, there are two types of execution: blind and readback scrubbing. Before enabling scrubbing, it is required to map the FPGA frame addresses by executing the Mapping operation mode or previously saving them on the Golden memory. The scrubbing can be defined as periodic with a delay between each memory scrubbing, or just one time. If a periodic execution is configured in the registers, the GRSCRUB repeats the scrubbing operation after a configured delay and only if it is still enabled. Otherwise, the OPDONE bit of the Status Register (STATUS) is set, and the GRSCRUB return to the idle state.

The following sections describe in more detail the GRSCRUB operational modes.

### 55.3.1 GRSCRUB operational modes

The GRSCRUB has five operation modes that can be selected in the OPMODE of the Configuration Mode Register (CONFIG) and are described in table 691. The Idle mode is the default state of the GRSCRUB. The operational mode must be configured before, or at the same time, the GRSCRUB is enabled. Also, the OPDONE and SCRERR bits in the Status Register (STATUS) must be cleared, see section 55.13.1 for more details.

**Note:** After enabling the GRSCRUB to run an operation mode, the values of the configuration registers must not be changed. Otherwise, it can cause an error in the GRSCRUB execution. If the GRSCRUB is disabled during execution, it will stop the operation, send the command to desynchronize the FPGA slave SelectMap, and return to the idle state. Thus, the current operation mode will be aborted.

Table 691. GRSCRUB operation modes description

Operation Mode	Code	Description
Idle	0000	Idle mode (default after reset).
Programming	0001	FPGA configuration. Program the configuration bitstream into the FPGA.
Scrubbing	0010	FPGA scrubbing. Perform the blind or readback scrubbing.
Mapping	0011	FPGA mapping frames address.
Golden CRC	0100	In this OPMODE the GRSCRUB computes a golden copy of the CRC data check and saves it on the Golden memory.

### 55.3.2 Idle mode

After reset, the GRSCRUB stays in idle mode waiting to be enabled. When the EN bit of the Configuration Mode Register (CONFIG) is disabled (logically 0), the GRSCRUB remains in idle mode.

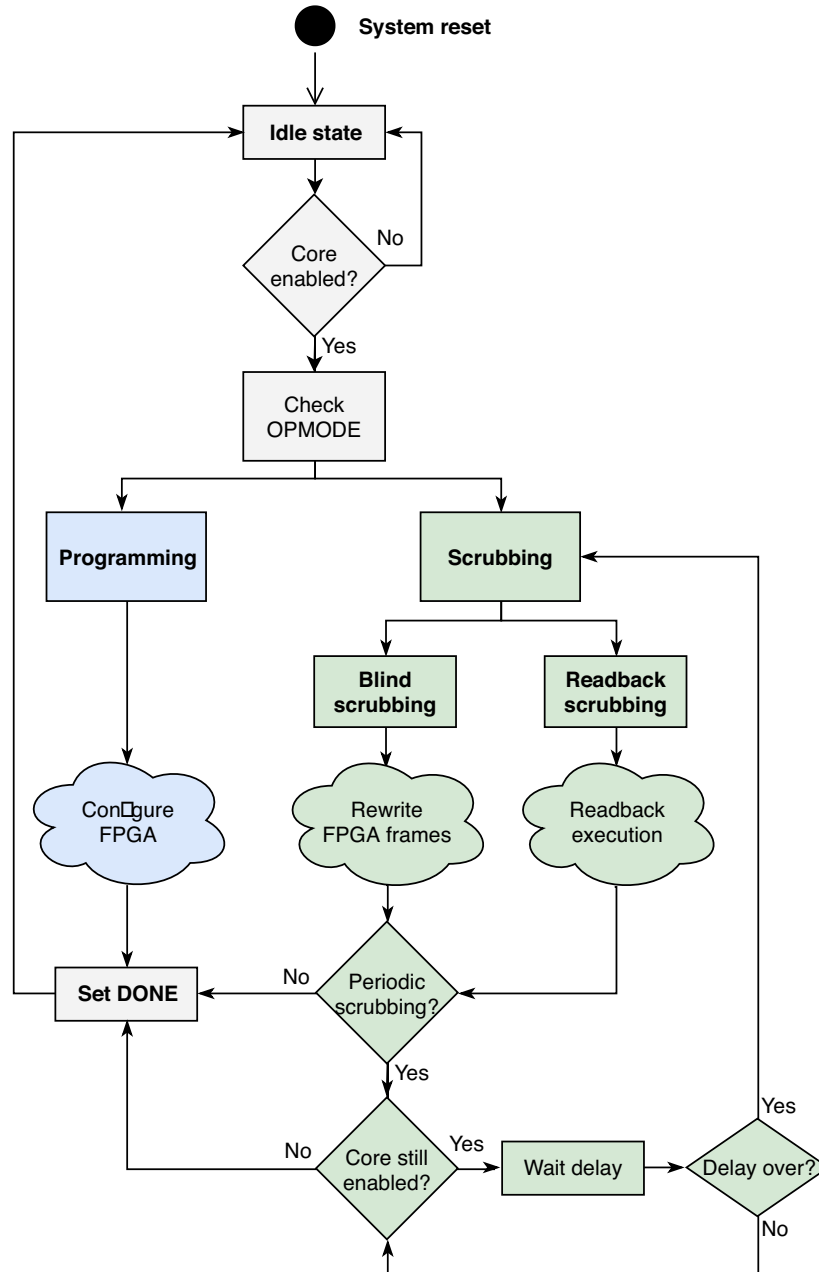


Figure 130. GRSCRUB flow for programming and scrubbing operation modes

### 55.3.3 Programming mode

The GRSCRUB can configure the FPGA by programming the configuration bitstream through the configuration interface. The configuration bitstream must be stored into the Golden memory, and the configuration bitstream address must be set in the GRSCRUB registers.

The following steps must be performed before enabling the GRSCRUB to execute the programming mode:

- The configuration bitstream must be stored in the Golden memory;
- The GRSCRUB must be disabled to configure the registers;
- The OPDONE and SCRERR bits in the Status Register (STATUS) must be cleared;
- Set the Configuration Mode Register (CONFIG) with the programming OPMODE (0001);



# LEON3FT Microcontroller

- Set the low and high configuration bitstream addresses in the Low Golden Bitstream Address Register (LGBAR) and High Golden Bitstream Address Register (HGBAR), respectively;
- Set the FPGA Device Identifier Register (IDCODE).

After setting the registers, the GRSCRUB can be enabled by writing the logical 1 in the EN bit of the Configuration Mode Register (CONFIG). When the programming phase is finished, the OPDONE bit goes to high, and an interrupt is generated (if interrupts are enabled).

## 55.3.4 Scrubbing mode

The user can define the scrubbing operational mode as blind or readback. Since the FPGAs are frame-oriented, the configuration memory is verified considering the frame size. For instance, the frame length of the Xilinx UltraScale FPGA family is 123 words of 32 bits each, whereas it is 41 32-bit words for Virtex-5. The FPGA frame length and the total number of frames must be configured in the Frame Configuration Register (FCR).

A scrubbing run is defined as one execution of the blind or readback scrubbing in all the selected configuration frames. The scrubbing can be set to be periodic, which means that scrubbing runs are periodically executed in time.

**Note:** The scrubbing mitigation technique only fixes bit-flips in the FPGA configuration memory, it is up to the user to apply any additional method to mask errors and re-establish the state of the system. In addition, scrubbing does not cover soft-errors affecting User memory and dynamic data.

The steps below must be performed before enabling the GRSCRUB to execute the scrubbing mode. If a register has been previously set and the data has not changed, there is no need to reconfigure it.

- The configuration bitstream must be stored in the Golden memory;
- The frames addresses must be stored in the Golden memory;
- The FPGA must be previously programmed;
- The GRSCRUB must be disabled to configure the registers;
- The OPDONE and SCRERR bits in the Status Register (STATUS) must be cleared;
- Set the Configuration Mode Register (CONFIG) with the scrubbing OPMODE (0010);
- Set whether the scrubbing mode is blind (logical 0) or readback (logical 1) in the SCRMM bit of the Configuration Mode Register (CONFIG). Blind scrubbing is set by default;
- Set whether the scrubbing run is just one time (logical 0) or periodic (logical 1) in the SCRUN bit of the Configuration Mode Register (CONFIG). One time is set by default. If a periodic run is set, the Delay Register (DELAY) should also be configured. No delay between runs is set by default;
- Set the low and high configuration bitstream addresses in the Low Golden Bitstream Address Register (LGBAR) and High Golden Bitstream Address Register (HGBAR), respectively;
- Set the address for the first golden frame in the Low Golden Start Frame Address Register (LGSFAR). Note that the first golden frame address is different from the low bitstream address. The LGSFAR should be the address in the Golden memory that saves the first word of the first frame in the bitstream;
- Set the address for the first frame of the FPGA configuration memory to be scrubbed in the Low Frame Address Register (LFAR);
- Set the FPGA Device Identifier Register (IDCODE);
- Set the number of frames and the frame length in the Frame Configuration Register (FCR).

Additional configuration is required for readback mode:

- The mask data must be stored in the Golden memory;

- Set the low mask address in the Low Golden Mask Address Register (LMASKAR);
- Set which data check is enabled to detect errors in the FFCEN and CRCEN bits of the Configuration Mode Register (CONFIG);
- Set if the readback scrubbing mode is only detection (logical 1) or detection and correction (logical 0) in the CORM bit of the Configuration Mode Register (CONFIG). Detection and correction is set by default;
- Set the Low Golden Frame Mapping Address Register (LFMAPAR) with the low address of the mapped frames in the Golden memory (only required if correction is selected);
- Optionally, to save the readback data in the Golden memory, the WRBKEN bit of the Configuration Mode Register (CONFIG) must be enabled. Also, the low memory address to save the readback data must be set in the Low Golden Readback Address Register (LGRBKAR). These steps are not required for other modes. Note that if the WRBKEN bit is enabled, the GRSCRUB does not detect or correct any error, it only copies the configuration data read from the FPGA to the Golden memory.

After setting the registers, the GRSCRUB can be enabled by writing 1 in the EN bit of the Configuration Mode Register (CONFIG). The OPDONE bit is only asserted if one time scrubbing is selected. The SCRUND bit goes high after each scrubbing execution.

### I. Blind scrubbing mode

In the blind scrubbing operation mode, the GRSCRUB will rewrite each FPGA frame from the configuration memory without any verification. Thus, the blind scrubbing does not provide the error detection capability. The blind scrubbing is configured to reprogram the configuration memory frames set in the Frame Configuration Register (FRC) and Low Frame Address Register (LFAR). Thus, the total number of frames, frame length, and the starting FPGA frame address must be configured. Only frames from the configuration block must be set. The frames from the FPGA configuration block (type 000) includes the configuration elements CLBs, I/Os, and CLKs. Blind scrubbing does not rewrite User memory elements. See the FPGA Configuration Manual for more details about frame block types.

### II. Readback scrubbing mode

In the readback scrubbing operation mode, the GRSCRUB verifies the integrity of each FPGA frame of the configuration memory, and then, in case of errors, rewrites the frame with correct data from the Golden memory. The error detection can be performed through CRC verification, and by comparing all frame bits with the golden copy. The latter is here defined as Full Frame Check (FFC). Each type of verification can be configured to be enabled or not. The CRC and FFC data checks are further described in the next sections.

The GRSCRUB can operate in three types of readback scrubbing modes: save the readback data into Golden memory; only error detection; and error detection and correction. For error detection operation, the mask data must be previously stored in the Golden memory.

The mode of saving the readback data into memory can only be used if the Golden memory is RAM, and it is useful when the user needs to check the readback data. The Low Golden Readback Data Address Register (LGRBKAR) must be set. On this mode, the mask data is not required.

The correction mode is used to correct a faulty frame during readback scrubbing. The GRSCRUB replaces the erroneous frame in the FPGA by the golden frame read from the Golden memory. To enable the error correction, the CORM bit in the Configuration Mode Register (CONFIG) must be set to 0. By default, the correction is enabled. However, if the CORM bit is set to 1, the errors are only detected and not corrected in the readback phase.

Figure 131 describes the GRSCRUB flow in scrubbing operation mode for readback execution with error detection and correction enabled. The GRSCRUB starts reading a frame word from the FPGA configuration memory. If CRC is enabled, the GRSCRUB computes the CRC signature of the word. In sequence, the word is compared with the golden copy, if FFC is enabled. At the end of the frame

# LEON3FT Microcontroller

the CRC code is checked and the frame is corrected if an error is detected. For FFC, the frame is corrected immediately when a faulty word is identified. After correcting a frame, the same frame is reread and rechecked to ensure the erroneous bits are fixed. If the corrected frame still presenting an error, it is defined as an uncorrectable error, and the next frame is read. In case of uncorrectable errors, the `UNCORRECTABLE_BIT_ERROR` is set, the `SCRERR` bit is asserted, and it is recommended to reprogram the FPGA.

Differently from the blind scrubbing, the readback mode allows detecting errors and correcting the frame only if necessary, at the expense of more accesses to the Golden memory to read golden and mask data.

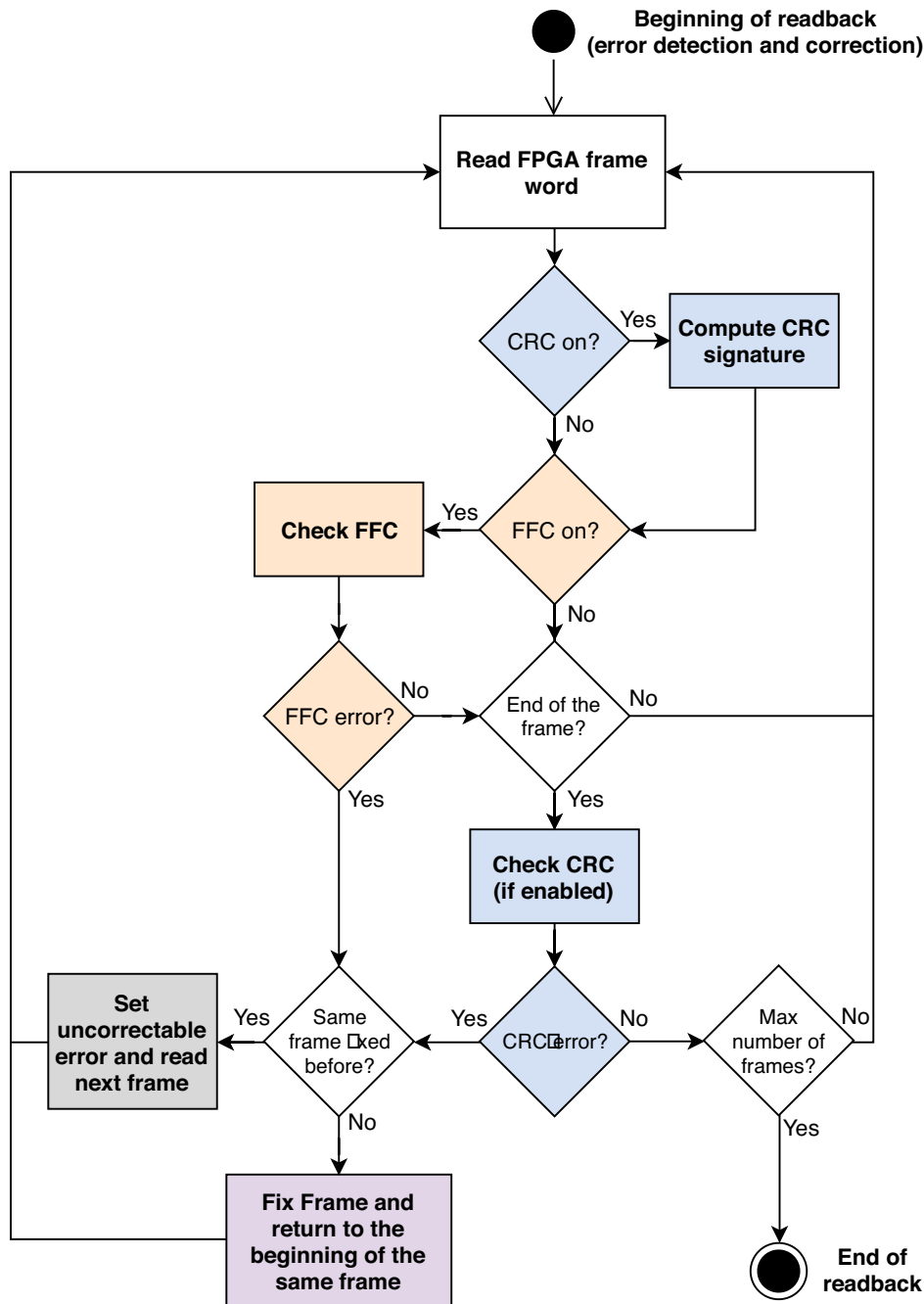


Figure 131. GRSCRUB flow in readback scrubbing mode for error detection and correction

# LEON3FT Microcontroller

## i. Cyclic Redundancy Check (CRC)

CRC is an error detection code that applies redundancy to check inconsistencies. A standard CRC checksum algorithm is computed for each FPGA frame. The 32-bit CRC (CRC32C) is used to verify the frame words.

The CRC32C polynomial is:

$$x^{32} + x^{26} + x^{23} + x^{22} + x^{16} + x^{12} + x^{11} + x^{10} + x^8 + x^7 + x^5 + x^4 + x^2 + x^1 + 1$$

The defined initial CRC signature for each frame is 0xFFFFFFFF. The first readback frame word is masked, using the corresponding mask word, then the CRC32C is applied using the signature. The output of this computation results in the next signature for the next readback frame word. That cycle is repeated for all words in the frame (frame length). The last computed signature corresponds to the frame CRC code.

During regular readback operation, the GRSCRUB reads the frame word from the FPGA, reads the mask word from the Golden memory, and computes the CRC signature. When it reaches the end of the frame, the generated CRC code is compared with the golden code from the Golden memory. If an error is detected, the faulty frame is corrected (if correction is enabled). Otherwise, the next frame is verified.

The CRC mode does not provide the total numbers of errors in the frame, and neither the error position. The number of errors detected present in Number of Errors Detected Register (ECNT) is related to the number of detected faulty frames. The CRC method has single error detection ensured. However, for more accurate error counting, the FFC method is recommended.

Before performing readback with CRC checking, the golden CRC codes must be previously saved into the Golden memory. The default configuration of the GRSCRUB assumes that the CRC codes are already saved on the Golden memory. Additionally, the GRSCRUB has the functionality of computing and saving the golden CRC codes, see section 55.3.6 for more details.

## ii. Full Frame Check (FFC)

In the FFC mode, the GRSCRUB compares all the configuration frame words with the golden words. Thus, the number of error bits per readback word is known. However, when the correction is enabled, the frame is corrected whenever the first error is detected. Thus, even though more faulty bits might be present, only one error bit is counted for the frame. FFC is a more reliable method to detect errors than CRC since each word is compared with its golden. Therefore, all faulty bits can be detected.

### 55.3.5 Mapping mode

Before scrubbing the FPGA in readback mode with correction, the addresses of the configuration frames must be stored in the Golden memory. These addresses are required to fix a specific frame in the FPGA. The default configuration of the GRSCRUB assumes that the addresses are already saved on the Golden memory.

Additionally, the GRSCRUB has the functionality of mapping the frames and saving the addresses on the memory. Only frames defined as configuration block are mapped, which means that all block memories are excluded from the mapping. It is recommended first to power reset and program the FPGA before executing the mapping mode. Also, the Golden memory must be RAM to allow writing the addresses.

Depending on the FPGA internal architecture, there may exist dummy frames between rows addresses in the FPGA configuration memory. The called row boundary is an internal FPGA address alignment that must be considered during the mapping phase. Since these addresses are not accessible from the GRSCRUB, all dummy frame addresses are indicated as 0x00000000. The number of frames in the rows boundaries must be set in the ROWBND bit of FPGA Setup Register (SETUP). For instance, Xilinx Virtex-5 has two boundary frames between rows.

# LEON3FT Microcontroller

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The steps below must be performed before enabling the GRSCRUB to execute the mapping mode. If a register has been previously set and the data has not changed, there is no need to reconfigure it.

- The GRSCRUB must be disabled to configure the registers;
- The OPDONE and SCRERR bits in the Status Register (STATUS) must be cleared;
- Set the Configuration Mode Register (CONFIG) with the mapping OPMODE (0011);
- Set the low mapping address in the Low Golden Frame Mapping Address Register (LFMAPAR);
- Set the address for the first frame of the FPGA configuration memory to be mapped in the Low FPGA Frame Address Register (LFAR). For instance, set the register to 0x00000000 to start from the first frame in the configuration memory.
- Set the number of rows boundaries in the ROWBND of the FPGA Setup Register (SETUP).
- Set the FPGA Device Identifier Register (IDCODE);
- Set the number of frames and the frame length in the Frame Configuration Register (FCR).

After setting the registers, the GRSCRUB can be enabled by writing the logical 1 in the EN bit of the Configuration Mode Register (CONFIG). When the mapping phase is finished, the OPDONE bit goes to high, and an interrupt is generated (if interrupts are enabled).

## 55.3.6 Golden CRC mode

The golden CRC codes must be stored in the Golden memory before enabling the readback scrubbing with CRC data check, see section 55.3.4 for more details about CRC. The GRSCRUB has the operation mode to compute and save the golden CRC codes. The Golden memory must be writable to allow writing the CRC golden codes.

The following steps must be performed before enabling the GRSCRUB to execute the golden CRC operational mode:

- The FPGA must be programmed;
- The frames addresses must be stored in the Golden memory;
- The GRSCRUB must be disabled to configure the registers;
- The OPDONE and SCRERR signals in the Status Register (STATUS) must be cleared;
- Set the Configuration Mode Register (CONFIG) with the golden CRC OPMODE (0100);
- Set the address for the first frame of the FPGA configuration memory to be scrubbed in the Low FPGA Frame Address Register (LFAR);
- Set the FPGA Device Identifier Register (IDCODE);
- Set the number of frames and the frame length in the FCR register;
- Set the low address for the first CRC code in the LCRCAR;
- The mask data must be previously stored in the Golden memory;
- Set the low mask address in the Low Golden Mask Address Register (LMASKAR).

After setting the registers, the GRSCRUB can be enabled by writing the logical 1 in the EN bit of the configuration register. When the GRSCRUB finishes the CRC computation, the OPDONE bit goes to high, and an interrupt is generated (if interrupts are enabled).

## 55.4 Mask data information

In the FPGA configuration memory there are dynamic bits that change their values during design execution, such as LUTRAMs and shift registers (SRL). During the configuration bitstream generation, the synthesis tool creates a mask file that indicates all dynamic bits as '1'. These bits should not be ver-

# LEON3FT Microcontroller

ified in the error detection steps. For that, the GRSCRUB applies the mask word to the readback word before the data checking, following steps below:

- 1) Read mask word from Golden memory;
- 2) All bits of the mask word are inverted: *NOT mask\_word*;
- 3) An *AND* operation of the readback word and the inverted mask word is performed.

- *Example:*

*mask\_word: 0x0000FFFF*

*readback\_word: 0x0FE50400*

*Result: readback\_word AND (NOT mask\_word) = 0x0FE50000*

*Thus, only 0x0FE50000 is applied to the fault detection methods.*

The mask data must be saved on the Golden memory and the start address should be set in the Low Golden Mask Address Register (LMASKAR). Since the GRSCRUB accesses only the masked data from the configuration frames (i.e., configuration block 000), it is not required to store the entire file in the Golden memory. However, the mask words must exactly corresponding to the readback words. Thus, the first mask word, whose address is set in the LMASKAR register, is related to the first word of the first readback frame, whose address is set in the Low FPGA Frame Address Register (LFAR).

The mask file has the same format as the configuration bitstream file. If the user decides to store only the mask words related to the scrubbed frames, the correlation between both must be matched, misalignment would cause erroneous verification of the bits.

Since the masked bits are not verified in the readback mode, faults affecting those bits cannot be detected.

## 55.5 FPGA frame information

Table 692 shows the configuration bitstream and fame length for Xilinx Virtex-5 and Kintex UltraScale FPGAs as example.

**Note:** Each FPGA device has different configuration bitstream length, number of frames, and frame length. See the FPGA documentation for more information.

Table 692. Configuration bitstream information for Xilinx Virtex-5 and Kintex UltraScale FPGAs

	Virtex-5 (XC5VFX130T)	Kintex UltraScale (KU060)
Configuration bitstream length	6,154,368 bytes	24,124,908 bytes
Total number of frames	37,520 frames	49,030 frames (plus 537 overhead words)
Block configuration frames <sup>ab</sup>	25,980 frames (4,260,720 bytes)	37,499 frames (18,449,508 bytes)
Frame length	41 32-bit words	123 32-bit words

a. Only the configuration frames are verified (block type 000: CLBs, DSPs, and IOBs).

b. Block RAM contents are not included (block type 001).

## 55.6 Golden memory

The GRSCRUB requires access to a Golden memory in which the golden data must be stored. The memory can be ROM or RAM, and the access is made through the AMBA AHB bus. The stored data is related to the golden configuration bitstream, mask file, mapped frame addresses, and golden CRC codes. Figure 132 describes an example of data saved in the Golden memory and the GRSCRUB registers that must be configured, as follows:

- Golden configuration bitstream: The entire configuration bitstream must be saved on memory. The Low Golden Bitstream Address Register (LGBAR) and High Golden Bitstream Address Register (HGBAR) correspond to the addresses of the first and last configuration bitstream

# LEON3FT Microcontroller

words, respectively. The Low Golden Start Frame Address Register (LGSFAR) is the address in the Golden memory of the first word of the first frame to be scrubbed.

- Mask data: The required mask data is directly related to the scrubbed frames. The Low Golden Mask Address Register (LMASKAR) is the address of the first mask word of the first frame word to be scrubbed.
- Mapped frames addresses: The mapped addresses are also directly related to the scrubbed frames. The Low Golden Frame Mapping Address Register (LFMAPAR) is the address in the Golden memory of the first mapped frame to be scrubbed.
- CRC codes: One CRC code is saved per frame. The Low Golden CRC Address Register (LCRCAR) is the address in the Golden memory of the first golden CRC code of the first frame to be scrubbed.
- The FCNT and FLEN bitfields of the Frame Configuration Register (FCR) are the number of scrubbed frames and length of each frame, respectively. Therefore, they represent the number of memory positions that must be sequentially accessed by the GRSCRUB in each operation.

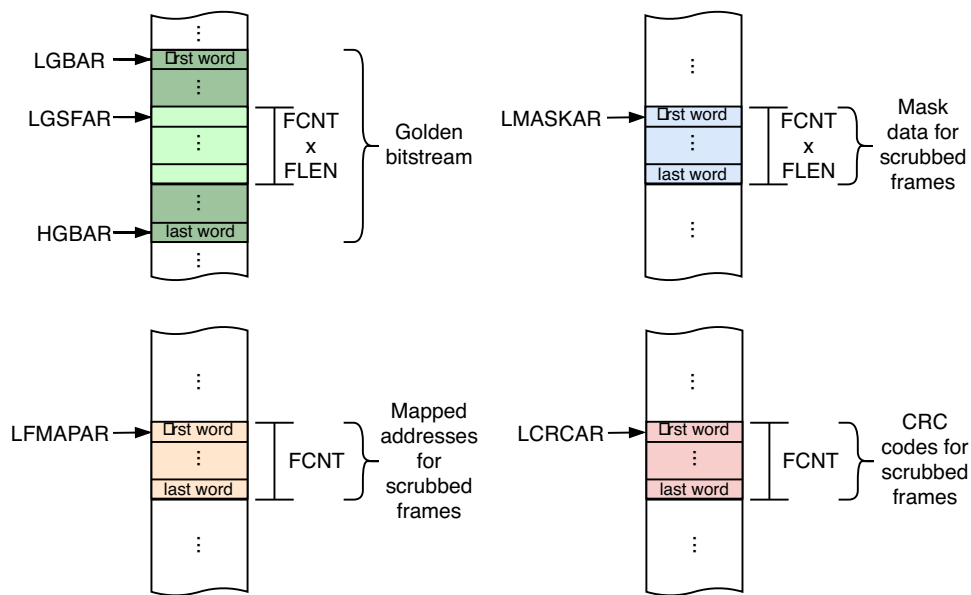


Figure 132. Example of data storage configuration in the Golden memory and the relation with the GRSCRUB registers

As an example, Table 693 describes the storage length required for Xilinx Virtex-5 and Kintex UltraScale FPGAs. Note that each FPGA device has different configuration bitstream length. See the FPGA documentation for more information.

Table 693. Description of required Golden memory storage for Virtex-5 and Kintex UltraScale FPGAs

Data Memory	Virtex-5 [XC5VFX130T] (bytes)	Kintex UltraScale [KU060] (bytes)
Configuration bitstream	6,154,368	24,124,908
Mask <sup>a</sup>	4,260,720	18,449,508
Mapped frame addresses <sup>b</sup>	103,920	149,996
CRC codes	103,920	149,996
<b>Total required storage</b>	<b>10,645,661</b>	<b>42,907,220</b>

a. Since the GRSCRUB accesses only the mask data related to the configuration frames, it is not required to store the entire file.

b. Only configuration frames are mapped.

# LEON3FT Microcontroller

## 55.7 SelectMap configuration interface

The FPGA slave SelectMap configuration interface is used to load the configuration bitstream into the FPGA and for scrubbing operations. The GRSCRUB connects directly to the SelectMap pins, which are controlled and used as follows:

- **CCLK:** The SelectMap configuration clock is provided by the system, and it is controlled by the GRSCRUB clock enable signal (SMAPO.clk\_en). By stopping the CCLK, it is possible to pause the data loading or reading from the SelectMap. The system design must provide a buffer to enable/disable the CCLK based on SMAPO.clk\_en. The implementation details of the required setup are further described. See the FPGA Data Sheet to details about the maximum slave SelectMap CCLK frequency.
- **PROGRAM\_B:** This signal is used to clean the FPGA configuration logic before starting the programming phase. The GRSCRUB set the PROGRAM\_B to low during the number of clock cycles defined in the TPROG register. See in the FPGA documentation the minimum pulse width required. By default, TPROG is 150 clock cycles.
- **INIT\_B:** It indicates when the FPGA is ready to receive configuration data. It also indicates any configuration or readback errors by low pulse.
- **DONE:** The GRSCRUB monitors the FPGA DONE signal to identify the completion the configuration sequence.
- **M[2:0]:** The configuration mode pins must be configured to logical "110" to select the slave SelectMap interface. For that, the pins can be tied directly to high or low level, or connected to the M pins of the GRSCRUB.
- **D[31:0]:** The bidirectional data bus is used for configuration and scrubbing operations. The RDWR\_B signal defines the direction of the pins. SelectMap supports 8-bit (D[7:0]), 16-bit (D[15:0]), or 32-bit (D[31:0]) data bus widths. The bus width must be informed in the smap\_buswide configuration option of the GRSCRUB, which has independent input and output data buses. The system is responsible for multiplexing the data signals, based on RDWR\_B, and provide the connection to the SelectMap bidirectional data bus.
- **RDWR\_B:** It is used to select the direction of the data bus. When RDWR\_B is high (logical 1), the SelectMap data pins are outputs (reading from the FPGA). Otherwise, the bus is input (loading data to the FPGA). The GRSCRUB only changes the RDWR\_B when the SelectMap interface is disabled (i.e., when CSI\_B is logically 1).
- **CSI\_B:** This signal enables (logical 0) and disables (logical 1) the SelectMap interface.

In order to allow the GRSCRUB to access and control the slave SelectMap interface, the generated FPGA configuration bitstream must be configured following the requirements presented in table 694.

Table 694. Example of configuration bitstream settings for enabling the FPGA slave SelectMap interface

<b>Synthesis tool</b>	- Vivado Design Suite 2018.1; or - ISE Design Suite 14.7
<b>Configuration bitstream settings</b>	- Enable the mask file generation - Do not prohibit readback in the configuration bitstream security settings - Do not use encryption in the configuration bitstream - Set the SelectMap pins to persistent in the configuration bitstream generator (bitgen) <sup>a</sup> : -g Persist:Yes or BITSTREAM.CONFIG.PERSIST YES - Set the constraints to allow programming and readback the FPGA through slave SelectMap interface: CONFIG CONFIG_MODE=S_SELECTMAP32+READBACK

a. The ICAP interface cannot be used in the FPGA design if Persist:Yes is set.



# LEON3FT Microcontroller

## 55.8 Soft-errors affecting the FPGA configuration interface

The FPGA configuration interface might also be affected by soft-errors, which may lead to catastrophic results during the scrubbing operation. For instance, if during a blind scrubbing the FPGA frame address register is affected and its value is changed to other valid address, all the following frames would be wrongly overwritten, and the design would be compromised.

Therefore, the GRSCRUB verifies the integrity of the FPGA configuration interface before each new scrubbing run. The verification is performed by reading a specific frame and checking its address. If the returned address is precisely the expected, the interface is considered responsive, and the scrubbing run starts. Otherwise, the CI\_INTEGRITY\_ERROR is reported. In this case, it is recommended to power cycle the FPGA. To enabling the verification feature, the CICHECK bit in the Setup Register (SETUP) must be 1.

Additionally, a safer approach is to set up the configuration interface for each scrubbed frame, instead of configuring all frames at once. For instance, writing one frame at time during blind scrubbing avoids overwritten the entire memory in case of errors in the FPGA frame address register. The BLKFRAME bitfield in the Setup Register (SETUP) defines the number of frames to be scrubbed sequentially during blind scrubbing or readback. If BLKFRAME is 0, all frames are scrubbed at once. The default is scrubbing only one frame at time (BLKFRAME = 1).

## 55.9 Interrupts

Interrupts are generated to indicate task finished (when the OPDONE bit is asserted) and internal errors in the GRSCRUB (when the SCRERR bit is asserted). Additionally, when the SCRUND bit is asserted, an interrupt can be generated.

Interrupts are disabled by default. The IRQDEN, IRQEEN and IRQSDEN bits of the Configuration Mode Register (CONFIG) should be high to allow interrupts for OPDONE, SCRERR, and SCRUND, respectively. All interrupts are connected to the interrupt controller to inform the processor of the events. The interrupts are pulse signals, being asserted for one clock cycle.

The usual procedure is that an interrupt routine handles the interrupt bits in the Status Register (STATUS). When it is finished, it clears the status bits by writing one, and the GRSCRUB can be enabled again.

## 55.10 GRSCRUB error codes

Table 695 describes the GRSCRUB internal error codes. When an internal error occurs, the GRSCRUB set the ERRID bit of the Status Register (STATUS) with the error code, set the SCRERR to high, and launches an interrupt (if interrupts are enabled).

For all errors, except for UNCORRECTABLE\_BIT\_ERROR, the GRSCRUB safely stops the current operation, finishes the synchronization with the FPGA, waits for the end of the last memory access, and returns to the idle state. The SCRERR bit must be cleared before enabling the GRSCRUB again and starting a new operation. The UNCORRECTABLE\_BIT\_ERROR means that the GRSCRUB failed to correct an FPGA frame during readback operation. Then, this error is reported, and the GRSCRUB continues the scrubbing operation.

The DMA errors are related to the Golden memory and are most likely to occur due to invalid memory accesses. For the other errors, it is recommended to properly reset and reprogram the FPGA.

Table 695. GRSCRUB internal error codes

Error	Code	Description
NO_ERROR	00000	GRSCRUB without errors. The GRSCRUB is working correctly. The SCRERR signal remains low, and no interrupt is launched.

Table 695. GRSCRUB internal error codes

Error	Code	Description
PROGRAM_ERROR	00001	<p>Error programming the FPGA configuration bitstream.</p> <p>This error is triggered when the INIT_B signal from the slave SelectMap interface pulses to low during the programming phase, which means error to configure the FPGA.</p> <p>Possible causes:</p> <ul style="list-style-type: none"> <li>- Frame length and number of frames wrongly set in the register;</li> <li>- Wrong configuration bitstream data stored in the Golden memory;</li> <li>- Wrong addresses set in the registers;</li> <li>- Wrong TPROG.</li> </ul>
UNCORRECTABLE_BIT_ERROR	00010	<p>Uncorrectable error(s) in the configuration memory during readback.</p> <p>After correcting a faulty frame, the replaced frame still presents an error. That might occur if the GRSCRUB failed to correct the frame or a new error affected the same frame in the time between correction and verification.</p> <p>Moreover, some upsets require two sequential scrubbing cycles to be corrected. The SRAM-based FPGAs present two types of configuration memory errors: a single point error is defined when an upset affects a function logic bit, and a burst of errors is defined when a single upset directly affects the state of multiple bits. The burst of errors may occur due to upsets in configuration bits responsible for controlling the status of other bits in the FPGA. When a control bit is flipped, all other bits under its control are also affected and may only return to the correct state after the original control bit is corrected. In the worst-case scenario, it is required two scrubbing cycles to recover all bits and return the configuration memory to a consistent state. The first scrubbing cycle will report UNCORRECTABLE_BIT_ERROR, and the second cycle will correct all remaining bits.</p> <p>This is the only internal error that does not lead the GRSCRUB to return to the idle state. The readback scrubbing continues the execution.</p> <p>In the UE_FRMID bitfield of the Error Frame Id Code Register (ERRFRMID) is informed the frame id where the last uncorrectable error occurred. The register is overwritten at each uncorrectable error.</p>
DMA_MEM_READ_ERROR	00011	<p>DMA error reading the Golden memory.</p> <p>Possible cause:</p> <ul style="list-style-type: none"> <li>- Illegal access.</li> </ul>
DMA_MEM_WRITE_ERROR	00100	<p>DMA error writing the Golden memory.</p> <p>Possible causes:</p> <ul style="list-style-type: none"> <li>- Illegal access.</li> <li>- PROM memory.</li> </ul>
READBACK_ERROR	00101	<p>Error during readback operation.</p> <p>This error is triggered when the INIT_B signal from the slave SelectMap interface pulses to low during the readback phase, which means error to read the FPGA frames.</p> <p>In the Frame Id Code Register (FRAMEID) is informed the id of the last frame scrubbed.</p> <p>Possible causes:</p> <ul style="list-style-type: none"> <li>- Frame length and number of frames wrongly set in the register;</li> <li>- Wrong addresses set in the registers;</li> <li>- The FPGA is not programmed;</li> <li>- Frames addresses are not stored in the Golden memory.</li> </ul>

Table 695. GRSCRUB internal error codes

Error	Code	Description
FRAME_MAPPING_ERROR	00110	<p>Error during mapping operation.</p> <p>This error is triggered when the INIT_B signal from the slave SelectMap interface pulses to low during the mapping phase, which means error to read the frame content or the address.</p> <p>In the Frame Id Code Register (FRAMEID) is informed the id of the last frame mapped.</p> <p>Possible causes:</p> <ul style="list-style-type: none"> <li>- Frame length and number of frames wrongly set in the register;</li> <li>- Wrong addresses set in the registers.</li> </ul>
WRITE_FRAME_ERROR	00111	<p>Error to write an FPGA frame.</p> <p>Error due to correcting frame during readback; or error during blind scrubbing.</p> <p>In the Frame Id Code Register (FRAMEID) is informed the id of the last written frame.</p> <p>Possible causes:</p> <ul style="list-style-type: none"> <li>- Frame length and number of frames wrongly set in the register;</li> <li>- Wrong configuration bitstream data stored in the Golden memory;</li> <li>- Wrong addresses set in the registers;</li> <li>- The FPGA is not programmed;</li> <li>- Frames addresses are not stored in the Golden memory.</li> </ul>
CI_INTEGRITY_ERROR	01000	<p>Error during verification of the configuration interface</p> <p>The configuration interface is not responsive or its integrity is compromised.</p> <p>Possible causes:</p> <ul style="list-style-type: none"> <li>- The FPGA configuration interface is not correctly set. For instance, the bitstream does not configure the SelectMap as specified.</li> <li>- The FPGA configuration interface was affected by soft-errors.</li> </ul> <p>It is recommended to power cycle the FPGA.</p>

## 55.11 Enabling and disabling the GRSCRUB

Before enabling the GRSCRUB, all the registers must be configured according the specific operation mode set. The GRSCRUB is enabled when the EN bit of the Configuration Mode Register (CONFIG) goes to high. The EN bit must stay high while the GRSCRUB is executing the operation. At the end of the execution, the GRSCRUB sets the OPDONE bit to high, sets the EN bit to low, and returns to the idle state.

After enabling the GRSCRUB, the registers should not be written. Otherwise, that can provoke a malfunction in the operation sequence. In addition, if the GRSCRUB is disabled (i.e., by setting the EN bit to low) during execution, the operation will not be finished. In that case, the GRSCRUB stops the current operation, finishes the synchronization with the FPGA, waits for the end of the last memory access, and returns to the idle state. The EN bit should only be enabled again after the GRSCRUB has returned to idle state.

The OPDONE and SCRERR bits should always be cleared before enabling the GRSCRUB and starting a new operation.

# LEON3FT Microcontroller

## 55.12 Bus master interface

## 55.13 Registers

The GRSCRUB is programmed through registers mapped into APB address space, which are shown in table 696. Only 32-bit single-accesses to the registers are supported.

Table 696. GRSCRUB registers

APB address offset	Register description
0x00	Status register (STATUS)
0x04	Configuration mode register (CONFIG)
0x08	FPGA device identifier register (IDCODE)
0x0C	Delay register (DELAY)
0x10	Frame configuration register (FCR)
0x14	Low FPGA frame address register (LFAR)
0x18	Low golden bitstream address register (LGBAR)
0x1C	High golden bitstream address register (HGBAR)
0x20	Low golden start frame address register (LGSFAR)
0x24	Low golden mask address register (LMASKAR)
0x28	Low golden frame mapping address register (LFMAPAR)
0x2C	Low golden CRC address register (LCRCAR)
0x30	Low golden readback data address register (LGRBKAR)
0x34	Number of errors detected register (ECNT)
0x38	FPGA setup register (SETUP)
0x3C	Capability register (CAP)
0x40	Frame id code register (FRAMEID)
0x44	Error frame id code register (ERRFRMID)

# LEON3FT Microcontroller

## 55.13.1 Status Register (STATUS)

Table 697.0x00 - STATUS - Status register

31	13	12	11	10	6	5	4	3	0
RESVD	SCRUND	HOLD	ERRID		SCRERR	OPDONE	STATE		
0	0	0	0		0	0	0		
r	wc	r	r		wc	wc	r		

- 31: 13 RESVD RESERVED
- 12 SCRUND Scrubbing run done. It indicates the end of a scrubbing run.  
The SCRUND bit goes high after each scrubbing execution in periodic run.  
Write one to clear.  
Generate interrupt (if enabled).
- 11 HOLD GRSCRUB in hold during periodic scrubbing (read only)  
It identifies when the GRSCRUB is waiting during the delay period.  
See the DELAY Register for more details.  
0 = release; 1 = GRSCRUB is holding due to delay
- 10: 6 ERRID Internal error code (read only)  
It is cleared when SCRERR is set to 0.  
Table 695 presents all error codes.
- 5 SCRERR GRSCRUB internal error: 0 = no error; 1 = error  
Write one to clear.  
Generate interrupt (if enabled).  
See ERRID to error details.
- 4 OPDONE Operation mode completed  
Write one to clear.  
Generate interrupt (if enabled).
- 3:0 STATE Current state (read only)  
It indicates the current operation mode of the GRSCRUB.  
STATE = OPMODE

## 55.13.2 Configuration Mode Register (CONFIG)

Table 698.0x04 - CONFIG - Configuration mode register

31	14	13	12	11	10	9	8	7	4	3	2	1	0
RESVD	IRQSD EN	FFC EN	CRC EN	WRBK EN	IRQE EN	IRQD EN	OPMODE		CORM	SCRM	SCRUN	EN	
0	0	0	0	0	0	0	0		0	0	0	0	
r	rw	rw	rw	rw	rw	rw	rw		rw	rw	rw	rw	

- 31: 14 RESVD RESERVED
- 13 IRQSDEN Interrupt enable for SCRUND signal: 0 = disable; 1 = enable (pulsed interrupt)
- 12 FFCEN Data check FFC enable: 0 = disable; 1 = enable
- 11 CRCEN Data check CRC enable: 0 = disable; 1 = enable
- 10 WRBKEN Enable writing readback data to Golden memory: 0 = disable; 1 = enable  
If enabled, the GRSCRUB does not detect or correct errors.
- 9 IRQEEN Interrupt enable for SCRERR signal: 0 = disable; 1 = enable (pulsed interrupt)
- 8 IRQDEN Interrupt enable for OPDONE signal: 0 = disable; 1 = enable (pulsed interrupt)
- 7: 4 OPMODE Operational mode  
0000 = idle mode (default)  
0001 = programming mode  
0010 = scrubbing mode  
0011 = mapping mode  
0100 = golden CRC mode

# LEON3FT Microcontroller

others = reserved

For more details, see the operational modes section.

- 3 CORM Correction mode:
  - 0 = detection and correction (default);
  - 1 = only detection
- 2 SCRM Scrubbing operational mode: 0 = blind (default); 1 = readback  
Blind scrubbing is set by default.
- 1 SCRUN Scrubbing run: 0 = one time (default); 1 = periodic  
In the periodic execution is considered the delay between runs, and the OPDONE only goes to high if the GRSCRUB is disabled during the delay period (when the HOLD bit is high). The SCRUND bit goes high after each scrubbing execution in periodic run.  
One time scrubbing is set by default.
- 0 EN GRSCRUB enable - starts operation mode: 0 = disable; 1 = enable  
After enabling the GRSCRUB, EN bit must be preserved high until the end of the operation (when OPDONE bit goes to high). Otherwise, the GRSCRUB is disabled, and the operation is not finished. See section 55.11 for more details.

### 55.13.3 FPGA Device Identifier Register (IDCODE)

Table 699.0x08 - IDCODE - FPGA device identifier register

31	0
IDCODE	
0	
rw	

31: 0 IDCODE FPGA device identifier code

The 32-bit FPGA identification code is defined in the FPGA specification and represents the specific device id based on the IEEE Std 1149.1 (JTAG).

### 55.13.4 Delay Register (DELAY)

Table 700.0x0C - DELAY - Delay register

31	0
DELAY	
0	
rw	

31: 0 DELAY Delay, in number of ticks, between full blind or readback scrubbing cycles. The delay is set only for periodic scrubbing runs, and it is applied after all configured frames being scrubbed. Therefore, after the last scrubbed frame, the GRSCRUB waits the number of ticks set in the DELAY register, then returns to the first frame configured, and restarts the scrubbing operation. No delay is set by default.  
A tick is counted for each rising edge of the tick\_in input signal of the GRSCRUB. The period in which the GRSCRUB stays in hold depends on the tick\_in frequency directly.

During the delay period while the GRSCRUB is waiting, the HOLD bit of the Status Register (STATUS) is set to high. When the delay is over, the HOLD bit is set to low.

If the EN bit of the Configuration Mode Register (CONFIG) is disabled while the GRSCRUB is waiting during the delay period, the GRSCRUB stops the delay, sets the OPDONE bit, and returns to idle state.

# LEON3FT Microcontroller

## 55.13.5 Frame Configuration Register (FCR)

Table 701.0x10 - FCR - Frame configuration register

31	25 24	9 8	2 1 0
RESVD	FCNT	FLEN	RESVD
0	0	0	0
r	rw	rw	r

- 31: 25 RESVD RESERVED
- 24: 9 FCNT Number of FPGA memory frames to be scrubbed
- 8: 2 FLEN Frame length: number of 32-bit words in a frame
- 1: 0 RESVD RESERVED

## 55.13.6 Low Frame Address Register (LFAR)

Table 702.0x14 - LFAR - Low frame address register

31	0
LFAR	
0	
rw	

31: 0 LFAR The lowest frame address in the FPGA range to be scrubbed. Thus, this is the starting frame address.

## 55.13.7 Low Golden Bitstream Address Register (LGBAR)

Table 703.0x18 - LGBAR - Low golden bitstream address register

31	0
LGBAR	
0	
rw	

31: 0 LGBAR The lowest golden configuration bitstream address in the Golden memory. This must be the address of the first dummy word in the configuration bitstream (0xFFFFFFFF), after the initial header.

All configuration bitstreams have an initial header with ASCII characters that provides some file information, which it is not required to program the FPGA. The synchronization phase starts at the first dummy word (0xFFFFFFFF).

## 55.13.8 High Golden Bitstream Address Register (HGBAR)

Table 704.0x1C - HGBAR - High golden bitstream address register

31	0
HGBAR	
0	
rw	

31: 0 HGBAR The highest golden configuration bitstream address in the Golden memory.

# LEON3FT Microcontroller

## 55.13.9 Low golden start frame address register (LGSFAR)

Table 705.0x20 - LGSFAR - Low golden start frame address register

31	0
LGSFAR	
0	
rw	

31: 0 LGSFAR The lowest address to the first configuration bitstream frame in the Golden memory.

## 55.13.10 Low Golden Mask Address Register (LMASKAR)

Table 706.0x24 - LMASKAR - Low golden mask address register

31	0
LMASKAR	
0	
rw	

31: 0 LMASKAR The lowest mask address in the Golden memory.

## 55.13.11 Low Golden Frame Mapping Address Register (LFMAPAR)

Table 707.0x28 - LFMAPAR - Low golden frame mapping address register

31	0
LFMAPAR	
0	
rw	

31: 0 LFMAPAR The lowest address of the FPGA frame mapping in the Golden memory.

## 55.13.12 Low Golden CRC Address Register (LCRCAR)

Table 708.0x2C - LCRCAR - Low golden CRC address register

31	0
LCRCAR	
0	
rw	

31: 0 LCRCAR The lowest address of the CRC data check in the Golden memory.

## 55.13.13 Low Golden Readback Data Address Register (LGRBKAR)

Table 709.0x30 - LGRBKAR - Low golden readback data address register

31	0
LGRBKAR	
0	
rw	

31: 0 LGRBKAR The lowest address to save readback data in the Golden memory.



# LEON3FT Microcontroller

## 55.13.14 Number of Errors Detected Register (ECNT)

Table 710.0x34 - ECNT - Number of errors detected register

31	16	15	0
UECNT		RECNT	
0		0	
rw		rw	

31: 16 UECNT Number of uncorrectable errors. UECNT is the number of frames that still presenting an error after correction, which means that the GRSCRUB was not able to correct the previous error or a new error occurred in the same frame in the time between correction and verification.  
Only active in readback scrubbing mode and when correction is enabled (CORM=0).

15: 0 RECNT Number of errors detected. Only enable in readback scrubbing mode. If the error correction is enabled (CORM=0), this counter represents the number of frames detected with error. Since the frame is corrected when the first error is detected, just one error is counted in the frame. If only detection is enabled (CORM=1) with FFC, this counter represents the total of error bits detected in the configuration memory. However, only one error is counter per frame for CRC data check.

The register is only cleared at the system reset, and the error counters accumulate over scrubbing runs. The user should clear the register to initiate a new count.

## 55.13.15 FPGA Setup Register (SETUP)

Table 711.0x38 - SETUP - FPGA setup register

31	30	29	22	21	20	19	12	11	4	3	0
RESVD	CICHECK	BLKFRAME	BITSWP EN	CISEL	TPROG	ROWBND	RESVD				
0	1	1	1	0	150	2	0				
r	rw	rw	rw	r	rw	rw	r				

- 31 RESVD RESERVED
- 30 CICHECK It enables the verification of the configuration interface integrity before each scrubbing run.  
0 = Disabled;  
1 = Enabled.
- 29: 22 BLKFRAME Maximum number of frames to be scrubbed at time (i.e., reading sequentially during readback, or writing sequentially during blind scrubbing).  
If BLKFRAME > 0, the frames are scrubbed by blocks, and a maximum of BLKFRAME frames is scrubbed each time. Thus, the number of frames defined in the FCNT bitfield of the Frame Configuration Register (FCR) is split into the BLKFRAME size. This feature is used to have more control of the FPGA configuration interface, and to avoid catastrophic results when the interface is affected by soft-errors.  
If BLKFRAME = 0, all frames set in the FCR are scrubbed sequentially at once.  
Default value = 1 (only one frame is scrubbed at time).
- 21 BITSWPEN FPGA bit swapping enable: 0 = disable; 1 = enable. Enabled by default
- 20 CISEL Configuration interface selected (read only):  
0 = SelectMap;  
1 = Not used.
- 19: 12 TPROG Number of clock cycles to wait with PROGRAM\_B signal asserted for FPGA programming (PROGRAM\_B pulse width). Check the target FPGA Data Sheet for the TPROGRAM pulse width. One microsecond is safe for most Xilinx FPGAs.  
TPROG >= 1 us / smapelki\_period  
Default value = 150 (wait 150 clock cycles).
- 11: 4 ROWBND Row boundary alignment: number of FPGA frames in the rows boundaries.  
Default value = 2 (two frames in the rows boundaries).  
It must be zero if there is no row boundaries in the FPGA.
- 3: 0 RESVD RESERVED

# LEON3FT Microcontroller

## 55.13.16 Capability Register (CAP)

Table 712.0x3C - CAP - Capability register

31	23	22	20	19	18	17	16	15	4	3	0
RESVD		DATAACK		SMBUS		CINT		FAMILY		RESVD	
0		0		0		0		0		0	
r		r		r		r		r		r	

- 31: 23 RESVD RESERVED
- 22: 20 DATAACK Supported data checks (read only):  
  - bit#20 = FFC;
  - bit#21 = CRC;
  - bit#22 = Not used.
- 19: 18 SMBUS SelectMap bus wide in bits (read only):  
  - 00 = Not used;
  - 01 = Not used;
  - 10 = Not used;
  - 11 = Not used.
- 17: 16 CINT Supported configuration interfaces (read only):  
  - bit#16 = SelectMap
  - others = Not used.
- 15: 4 FAMILY Supported FPGA families (read only):  
  - bit#4 = Xilinx Virtex-5;
  - bit#5 = Xilinx Kintex UltraScale;
  - others = Not used.
- 3: 0 RESVD RESERVED

## 55.13.17 Frame Id Code Register (FRAMEID)

Table 713.0x40 - FRAMEID - Frame id code register

31	16	15	0
RESVD		FRMID	
0		0	
r		rw	

- 31: 16 RESVD RESERVED
- 15: 0 FRMID Frame id of the current scrubbed frame.  
  - It is updated at every new scrubbed frame.
  - Frame id is also updated during mapping phase.

The frame id represents the identification of the frame, which is defined from 0 to FCNT-1. Thus, FRMID 0 means the first frame, whereas the FRMID FCNT-1 means the last one.

In case of READBACK\_ERROR, FRAME\_MAPPING\_ERROR, or WRITE\_FRAME\_ERROR errors, the FRMID represents the last frame processed by the GRSCRUB. In these cases, the reported FRMID might not be precise. The GRSCRUB has an internal FIFO to receive the amount of data from the FPGA, and the current frame id takes into account only the processed data.

The register is only cleared at the system reset.

# LEON3FT Microcontroller

## 55.13.18 Error Frame Id Code Register (ERRFRMID)

Table 714.0x44 - ERRFRMID - Error frame id code register

31	16	15	0
UE_FRMID		ERR_FRMID	
0		0	
rw		rw	

31: 16    UE\_FRMID Frame id of the last frame with uncorrectable error.  
 It is only updated if a new uncorrectable error occur.  
 This bitfield is only valid if the UECNT from the Number of Errors Detected Register (ECNT) is higher then 0.

15: 0    ERR\_FRMID    Frame id of the last frame detected with error during readback.  
 It is only updated if a new frame with error is detected.

The frame id represents the identification of the frame, which is defined from 0 to FCNT-1. Thus, FRMID 0 means the first frame, whereas the FRMID FCNT-1 means the last one.

The register is only cleared at the system reset.

## 55.14 Implementation

### 55.14.1 SelectMap timing parameters

All pins of the slave SelectMap interface on the FPGA are synchronous with the input clock (CCLK), except PROGRAM\_B that is an asynchronous reset. Refer to the Xilinx FPGA Configuration Guide to a description of the SelectMap pins and their functionalities.

The CCLK frequency (Fclk) is not necessarily the same as the system (microcontroller or FPGA design) clock (Fsys\_clk). System and SelectMap interface can run in different frequency domains, following the relation  $F_{sys\_clk} \geq F_{clk}$ . See the FPGA Data Sheet to details about the maximum slave SelectMap CCLK frequency. Also, the timing limitation due to the interface connection between the SelectMap and GRSCRUB should be considered to define Fclk.

Figures 133 and 134 present the timing characteristics of the SelectMap pins related to CCLK for data loading and reading, and table 715 describes the timing parameters. For timing information of the FPGA SelectMap interface, refer to the FPGA Data Sheet.

# LEON3FT Microcontroller

**Note:** The timing parameters are technology dependent.

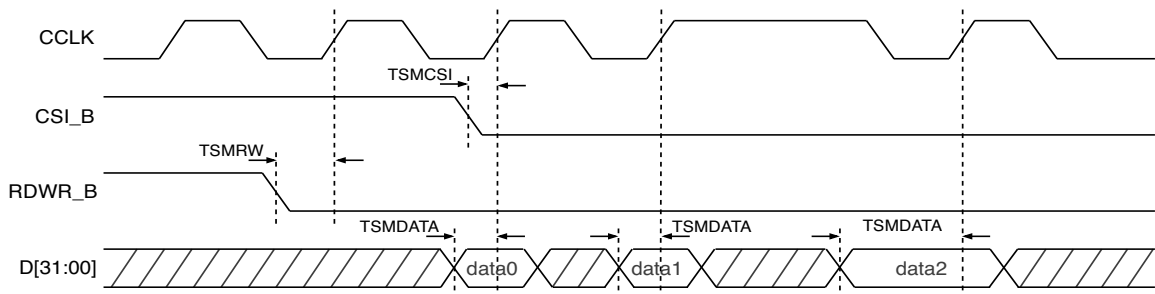


Figure 133. SelectMap timing characteristics for data loading to FPGA

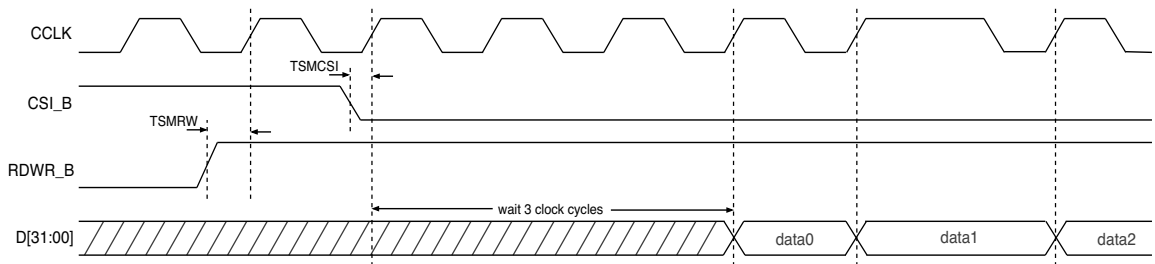


Figure 134. SelectMap timing characteristics for data reading from FPGA

Table 715. SelectMap timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
TSMCSDATA	D[31:00] setup/hold	Rising clock edge	TBD	-	ns
TSMCSCI	CSI_B setup/hold	Rising clock edge	TBD	-	ns
TSMRW	RDWR_B setup/hold	Rising clock edge	TBD		ns
TSMCO	D[31:00] clock to out in readback	Rising clock edge	-	TBD	ns

### 55.14.2 SelectMap clock enable

The SelectMap clock CCLK is controlled (enabled/disabled) by the SMAPO.clk\_en signal from the GRSCRUB. The GRSCRUB main clock (CLK signal) is the system clock. The system must also provide the SelectMap clock to the GRSCRUB (SMAPCLKI signal) and the CCLK to the FPGA. In addition, the system design must contain a dedicated register buffer to allow enabling/disabling the CCLK based on SMAPO.clk\_en.

### 55.14.3 Scrubbing run period

The period to execute one scrubbing run, which means the time to scrub all frames configured in the registers once, depends on the characteristics of the system presented below. Blind and readback scrubbing modes are affected by the following factors:

- Number of frames to be scrubbed, which is defined in the FCNT bitfield of Frame Configuration Register (FCR);
- Number of words in each frame, which is defined in the FLEN bitfield of Frame Configuration Register (FCR);
- The target Xilinx FPGA family;
- The GRSCRUB clock frequencies: CLK and SMAPCLKI signals;
- The required time to access the Golden memory.

# LEON3FT Microcontroller

Additional factors affect the readback scrubbing, as following:

- The selected error detection type, which can be FFC and/or CRC defined in the Configuration Mode Register (CONFIG);
- If error correction is enabled or not, which is defined in the CORM bit of the Configuration Mode Register (CONFIG);
- The number of errors detected in the scrubbing run, which is presented in the RECNT bitfield of the Number of Errors Detected Register (ECNT) (if correction is enabled).

Table 716 generically describes the time parameters that affects the scrubbing period.

Table 716. Generic timing description

Name	Description
SCRUBP	Scrubbing period
TFRD	Time to read one frame from the FPGA
TFWR	Time to write one frame to the FPGA
TD	Time to detect error in a frame
TC	Time to correct one frame

Considering the readback scrubbing mode with only detection enabled, the scrubbing period would be:

$$SCRUBP = [time\ to\ read\ frame\ and\ detect\ error] * [number\ of\ frames]$$

$$SCRUBP = (TFRD + TD) * FCNT$$

Considering the readback scrubbing mode with detection and correction enabled, the scrubbing period would be:

$$SCRUBP = [detection\ time] + [correct\ erroneous\ frames] + [recheck\ corrected\ frames]$$

$$SCRUBP = (TFRD + TD) * FCNT + (TC + TFWR) * RECNT + (TFRD + TD) * RECNT$$

# LEON3FT Microcontroller

## 56 LVDS IO

### 56.1 Overview

The LVDS receivers and transmitters can be configured and used as normal input and outputs controlled from software via registers describe in this chapter. Receiver inputs can be configured to generate interrupt on high or low level.

Function needs to be enabled in the clock gating unit and LVDS receivers and transmitters must be enabled in the system IO and LVDS configuration registers.

### 56.2 Operation

#### 56.2.1 system overview

n/a

#### 56.2.2 Detailed description

n/a

#### 56.2.3 Access control

LVDS IO status and configuration can be accessed via registers

### 56.3 Registers

Table 717. PLL control and status registers

APB address offset	Register
0x8030B000	LVDS Interrupt status
0x8030B074	LVDS Interrupt register
0x8030B078	LVDS Interrupt mask
0x8030B07C	LVDS Interrupt level
0x8030B010	LVDS output register
0x8030B080	LVDS Input register

Table 718. 0x8030B000 - STS - LVDS interrupt status register

31	RESERVED	4	3	2	1	0
	0x00000000	R3	R2	R1	R0	
	r	-	-	-	-	
		R	R	R	R	

- 31: 4 Reserved
- 3 LVDS Receiver input 0 (R3)
- 2 LVDS Receiver input 0 (R2)
- 1 LVDS Receiver input 0 (R1)
- 0 LVDS Receiver input 0 (R0)

Table 719. 0x8030B004 - IRQ - LVDS interrupt register

31		4	3	2	1	0
	RESERVED	R3	R2	R1	R0	
	0x00000000	-	-	-	-	
	r	wc	wc	wc	wc	

- 31: 4 Reserved
- 3 LVDS Receiver input 0 (R3)
- 2 LVDS Receiver input 0 (R2)
- 1 LVDS Receiver input 0 (R1)
- 0 LVDS Receiver input 0 (R0)

Table 720. 0x8030B008 - MASK - LVDS mask register

31		4	3	2	1	0
	RESERVED	R3	R2	R1	R0	
	0x00000000	0	0	0	0	
	r	rw	rw	rw	rw	

- 31: 4 Reserved
- 3 LVDS Receiver input 0 (R3)
- 2 LVDS Receiver input 0 (R2)
- 1 LVDS Receiver input 0 (R1)
- 0 LVDS Receiver input 0 (R0)

Table 721. 0x8030B00C - LVL - LVDS interrupt level register

31		4	3	2	1	0
	RESERVED	R3	R2	R1	R0	
	0x00000000	0	0	0	0	
	r	rw	rw	rw	rw	

- 31: 4 Reserved
- 3 LVDS Receiver input 0 (R3)
- 2 LVDS Receiver input 0 (R2)
- 1 LVDS Receiver input 0 (R1)
- 0 LVDS Receiver input 0 (R0)

Table 722. 0x8030B010 - CFG - LVDS configuration output register

31		6	5	4	3	2	1	0
	RESERVED	T5	T4	NA	T2	T1	T0	
	0x00000000	0	0	0	0	0	0	
	r	rw	rw	-	rw	rw	rw	

- 31: 6 Reserved
- 5 LVDS transmitter output 5 (T5) - Output register bit for LVDS transmitter 5
- 4 LVDS transmitter output 4 (T4) - Output register bit for LVDS transmitter 4
- 3 NA

# LEON3FT Microcontroller

Table 722. 0x8030B010 - CFG - LVDS configuration output register

2	LVDS transmitter output 2 (T2) - Output register bit for LVDS transmitter 2
1	LVDS transmitter output 1 (T1) - Output register bit for LVDS transmitter 1
0	LVDS transmitter output 0 (T0) - Output register bit for LVDS transmitter 0

Table 723. 0x8030B080 - STS - LVDS input register

31		4	3	2	1	0
	RESERVED	R3	R2	R1	R0	
	0x00000000	0	0	0	0	
	r	rw	rw	rw	rw	

31: 4	Reserved
3	LVDS Receiver input 0 (R3)
2	LVDS Receiver input 0 (R2)
1	LVDS Receiver input 0 (R1)
0	LVDS Receiver input 0 (R0)



# LEON3FT Microcontroller

## 57 Electrical description

All electrical specifications are defined at package solder point level, unless otherwise stated.

Specifications in this whole chapter have been derived from simulation of GR716B or validation of GR716A. The GR716B microcontroller is currently in a development phase, and parameter characterization validation and device qualification are yet to be done. All parameter values in this whole chapter are TBC.

### 57.1 Absolute maximum ratings

Table 724. Absolute maximum ratings <sup>1)</sup>

Symbol	Parameter	Rating		Units
		Min.	Max.	
	Voltage between any supply domain grounds <sup>2)</sup>	-0.3	0.3	V
V <sub>DD_CORE</sub> <sup>5)</sup>	DC Supply for Core	-0.3	2.2 <sup>9) 10)</sup>	V
V <sub>DD_IO</sub> <sup>5)</sup>	DC Supply for I/O	-0.3	4.0	V
V <sub>DD_LVDS</sub> <sup>5)</sup>	DC Supply for LVDS I/O	-0.3	4.0	V
V <sub>DD_LDO</sub> <sup>5)</sup>	DC Supply for LDO	-0.3	V <sub>DD_IO</sub> + 0.3 <sup>8)</sup>	V
V <sub>DDA</sub> <sup>5)</sup>	DC Supply for Analog domains, except PLL	-0.3	4.0	V
V <sub>DDA_PLL</sub> <sup>5) 7)</sup>	DC Supply for PLL (supplied from internal LDO)	-0.3	2.2 <sup>10)</sup>	V
V <sub>GPIO</sub> <sup>5) 12)</sup>	Voltage between GPIO pin and ground	-0.3	V <sub>DD3V3</sub> + 0.3 <sup>8)</sup>	V
V <sub>DIO_IN</sub> <sup>5) 12)</sup>	Digital CMOS Input voltage	-0.3	V <sub>DD_IO</sub> + 0.3 <sup>8)</sup>	V
V <sub>DIO_OUT</sub> <sup>5) 12)</sup>	Digital CMOS Output voltage	-0.3	V <sub>DD_IO</sub> + 0.3 <sup>8)</sup>	V
V <sub>LVDS_IN</sub> <sup>5)</sup>	LVDS Input voltage per pin (pin 48-53)	-4.5	5.6	V
V <sub>LVDS_OUT</sub> <sup>5) 13)</sup>	LVDS Output voltage per pin (pin 42-47)	-0.3	4.0	V
I <sub>GPIO_IN</sub> <sup>12)</sup>	GPIO current when configured as input or HiZ (ESD-diode current max 10mA)	-10	10	mA
I <sub>GPIO_OUT</sub> <sup>12)</sup>	GPIO current when configured as output (ESD-diode current max 10mA)	-10	10	mA
I <sub>DIO_IN</sub> <sup>12)</sup>	Digital Input current (ESD-diode current max 10mA)	-10	10	mA
I <sub>DIO_OUT_HiZ</sub> <sup>12)</sup>	Digital Output current when configured as HiZ (ESD-diode current max 10mA)	-10	10	mA
I <sub>DIO_OUT</sub> <sup>12)</sup>	Digital Output current when configured as output (ESD-diode current max 10mA)	-10	10	mA
I <sub>DD_LDO</sub>	LDO current	-10	900 <sup>11)</sup>	mA
V <sub>ref</sub> <sup>7)</sup>	Bandgap voltage reference	-0.3	V <sub>DDA</sub> + 0.3 <sup>8)</sup>	V
R <sub>ref</sub> <sup>6)</sup>	Bandgap current reference	-0.3	V <sub>DDA</sub> + 0.3 <sup>8)</sup>	V
V <sub>refbuf</sub>	Reference buffer voltage	-0.3	V <sub>DDA</sub> + 0.3 <sup>8)</sup>	V
I <sub>refbuf</sub>	Sourcing current for reference buffer enabled (ESD-diode current max 10mA)	-3	30	mA
C <sub>RST</sub> <sup>7)</sup>	Reset timing capacitor	-0.3	V <sub>DD_CORE</sub> + 0.3	V
V <sub>XO_ANA</sub> <sup>14)</sup>	Crystal oscillator port (pin 59-60)	-0.3	V <sub>DD_CORE</sub> + 0.3	V

# LEON3FT Microcontroller

 Table 724. Absolute maximum ratings <sup>1)</sup>

Symbol	Parameter	Rating		Units
		Min.	Max.	
T <sub>store</sub>	Storage Temperature	-65	150	°C
T <sub>solder</sub>	Lead Temperature (Soldering 10 sec.)		250	°C
T <sub>j</sub>	Junction Temperature		150	°C
Θ <sub>JC</sub> (ceramic)	Thermal Resistance, Junction to Case <sup>4)</sup>		6	°C/W
P <sub>D</sub> <sup>3)</sup>	Power Dissipation		4	W
V <sub>HBM</sub>	ESD level		4 <sup>14)</sup>	kV

Note 1: Extended operation at the maximum levels may degrade the performance and affect the reliability of the device. Exceeding the maximum levels may permanently damage the device.

Note 2: Within one and the same supply domain, all GND resp V<sub>DD</sub> pins must be connected to the same GND resp V<sub>DD</sub> plane on PCB. Any externally applied voltage difference between GND pins, resp between V<sub>DD</sub> pins where there are more than one pin per V<sub>DD</sub> domain, can create harmful circulating ground resp supply currents inside the package.

Note 3: The thermal resistance, Θ<sub>JC</sub>, sets the maximum power dissipation, P<sub>D</sub>, assuming that the package is mounted on PCB with main heat flowing through the main heat-sinking path for the package. Otherwise, maximum power dissipation limit will be significantly lower.

Note 4: Case means bottom surface of package, which is the main heat-sinking path out of this package.

Note 5: Values are relative to their dedicated supply ground.

Note 6: This pin shall not be connected, except for external resistor to ground.

Note 7: This pin shall not be connected, except for external capacitor to ground.

Note 8: Voltage must not exceed 4.0V

Note 9: Voltage must not exceed V<sub>DD\_LDO</sub> + 0.3V

Note 10: Voltage must not exceed V<sub>DD\_IO</sub> + 0.3V. To guarantee this limit during all kinds of system supply transients (especially rapid unexpected discharge of V<sub>DD\_IO</sub>), a schottky power diode in reverse bias between V<sub>DD\_CORE</sub> and V<sub>DD\_IO</sub> should be considered on PCB. This diode is strongly recommended when V<sub>DD\_CORE</sub> is Externally supplied (V<sub>DD\_LDO</sub> connected to V<sub>DD\_CORE</sub>), and is especially important if total capacitance on V<sub>DD\_CORE</sub> net in the whole power system is large.

Note 11: Repetitive pulse transients must be limited to maximum 1.1A<sub>Peak</sub>, with maximum pulse length in the order of 100us. The single pulse transient during LDO start up will not be harmful for the LDO when the recommended decoupling values for the LDO are approximately fulfilled.

Note 12: All CMOS IO ports are non-cold-spare ports. These inputs and outputs have ESD protection via on-chip diodes to IO ground and IO supply. Forward bias voltage for on-chip ESD protection diodes should not exceed 0.3 V and DC current should not exceed 10mA. For equivalent IO port schematics see section 57.4. For V<sub>GPIO</sub>, the GPIO port location determines when V<sub>DD3V3</sub> is V<sub>DD\_IO</sub> or V<sub>DDA</sub>.

Note 13: V<sub>LVDS\_OUT</sub> is applicable only in LVDS cold-spare mode (V<sub>DD\_LVDS</sub>=-0.1V to 0.2V) and LVDS output-disable mode (V<sub>DD\_LVDS</sub>=3.0V to 3.6V). It is not applicable during the transition V<sub>DD\_LVDS</sub>=0.2V to 3.0V, which is an absolute maximum limitation, meaning that externally applied voltage other than GND onto the LVDS pins must be avoided during this supply transition. I.e., system cold-spare switching of a multi-driver LVDS bus must first power down any active LVDS driver into cold-spare mode, and then power up the one LVDS driver to be active.

The LVDS outputs on GPIO ports (pin 77-80) are non-cold-spare ports and have maximum limits according to GPIO ports, i.e., V<sub>LVDS\_OUT</sub> is not applicable.

Note 14: Crystal oscillator port (pin 59-60) has V<sub>HBM</sub> of maximum 2kV.

# LEON3FT Microcontroller

## 57.2 Recommended operating conditions

Table 725. Recommended operating conditions <sup>1) 2)</sup>

Symbol	Parameter	Rating			Units
		Min.	Typ.	Max.	
	Voltage between any supply domain grounds	-0.1	0.0	0.1	V
V <sub>DD_CORE</sub> 4) 9)10)	DC Supply for Core  f <sub>intsys</sub> ≤ 50MHz f <sub>intsys</sub> ≤ 100MHz	1.62 1.71	1.8 1.9	1.98 <sup>3)</sup> 1.98 <sup>3)</sup>	V
V <sub>DD_IO</sub> <sup>4)</sup>	DC Supply for I/O	3.0	3.3	3.6 <sup>3)</sup>	V
V <sub>DD_LVDS</sub> <sup>4) 8)</sup>	DC Supply for LVDS I/O	3.0	3.3	3.6 <sup>3)</sup>	V
V <sub>DD_LDO</sub> <sup>4) 10)</sup>	DC Supply for LDO	3.0	3.3	3.6 <sup>3)</sup>	V
V <sub>DDA</sub> <sup>4) 8)</sup>	DC Supply for Analog domains, except PLL	3.0	3.3	3.6 <sup>3)</sup>	V
V <sub>DDA_PLL</sub> <sup>4) 7)</sup>	DC Supply for PLL (supplied from internal LDO)	1.7	1.85	1.98 <sup>3)</sup>	V
V <sub>GPIO</sub> <sup>4) 12)</sup>	Voltage between GPIO pin and ground	-0.1		V <sub>DD3V3</sub> +0.1	V
V <sub>DIO_IN</sub> <sup>4) 12)</sup>	Digital CMOS Input voltage	-0.1		V <sub>DD_IO</sub> +0.1	V
V <sub>LVDS_IN</sub> <sup>4) 13)</sup>	LVDS Input voltage per pin (pin 48-53)	-4.0 <sup>14)</sup>		5.0 <sup>3)</sup>	V
V <sub>LVDS_OUT</sub> <sup>4) 15)</sup>	LVDS Output voltage per pin (pin 42-47)	-0.1 <sup>12)</sup>		3.6 <sup>3)</sup>	V
I <sub>GPIO_OUT</sub>	GPIO current when configured as output	-5 <sup>3)</sup>		5 <sup>3)</sup>	mA
I <sub>DIO_OUT</sub>	Digital CMOS current when configured as output	-5 <sup>3)</sup>		5 <sup>3)</sup>	mA
I <sub>DD_LDO</sub>	LDO current	0 <sup>11)</sup>		700 <sup>11)</sup>	mA
V <sub>ref</sub> <sup>5)</sup>	Bandgap voltage reference		4.7		nF
R <sub>ref</sub> <sup>6)</sup>	Bandgap current reference		5.11		kΩ
I <sub>refbuf</sub>	Sourcing current for reference buffer enabled	-1 <sup>3)</sup>		20 <sup>3)</sup>	mA
C <sub>RST</sub> <sup>16)</sup>	Reset timing capacitor		100		nF
f <sub>XO</sub> <sup>17)</sup>	Crystal oscillator frequency	5		25	MHz
f <sub>intsys</sub> <sup>18)</sup>	Internal system clock frequency for Core logic	5		100 <sup>3)</sup>	MHz
f <sub>extsys</sub>	External input clock frequency for System clock (pin 57)			100 <sup>3)</sup>	MHz
f <sub>extspw</sub> <sup>19)</sup>	External input clock frequency for SpaceWire interface and PLL (pin 54)			200 <sup>3)</sup>	MHz
T <sub>case</sub> <sup>2)</sup>	Case Temperature	-55 <sup>3)</sup>		125 <sup>3)</sup>	°C

Note 1: Within recommended operating conditions, all functionality and performance parameters in this data-sheet are valid, and device long-term reliability is maintained.

Note 2: Analog performance specifications are guaranteed within -40°C to 110°C junction temperature, unless otherwise stated.

Note 3: To maintain device long-term reliability, this limit must be fulfilled, and Note 8 and Note 12 must be fulfilled where applicable.

Note 4: Values are relative to their dedicated supply ground.

# LEON3FT Microcontroller

Table 725. Recommended operating conditions <sup>1)2)</sup>

Symbol	Parameter	Rating			Units
		Min.	Typ.	Max.	
Note 5:	Connect 4.7 nF ceramic capacitor to ground, close to the pin with short wire, and not connected to anything else.				
Note 6:	Connect 5.11 kΩ ±1% <sub>INIT</sub> to ground, close to the pin with short wire, and not connected to anything else. The tolerance of this reference resistor will directly affect the accuracy of the DAC outputs. For high-precision DAC applications, a precision resistor should be considered, e.g. ±0.1% <sub>INIT</sub> ±10 ppm/°C thin metal film type.				
Note 7:	The PLL supply voltage, V <sub>DDA_PLL</sub> , is generated from internal voltage regulator. It shall be decoupled to PLL ground, V <sub>SSA_PLL</sub> , with ceramic capacitor of about 2 uF (typically 2.2 uF) close to pins with short wires, and V <sub>DDA_PLL</sub> shall not be connected to anything else.				
Note 8:	Any of the supply voltages V <sub>DDA</sub> or V <sub>DD_LVDS</sub> can be non-supplied. Then the supply must be grounded via maximum 400 Ω, to maintain device long-term reliability. This is not applicable for V <sub>DDA_PLL</sub> , where only decoupling capacitor is allowed. For LVDS cold-spare mode, V <sub>DD_LVDS</sub> must be -0.1 V to 0.2 V(TBD), which is fulfilled when V <sub>DD_LVDS</sub> is grounded via maximum 400 Ω. When V <sub>DDA_ADC</sub> is grounded it must be via maximum 200 Ω, and the three on-chip measurement channels into the three ADCs respectively must be configured to off state, to maintain device long-term reliability.				
Note 9:	The core supply voltage shall be decoupled by typically 10 nF to ground per V <sub>DD_CORE</sub> and GND pin pair. This supply can be generated from internal voltage regulator, and should then be decoupled also by at least 100 uF damped capacitors (typically 0.1 Ω in series with 100 uF), preferably times two for redundancy.				
Note 10:	In single supply mode, V <sub>DD_LDO</sub> is recommended to be connected to same 3.3 V supply as V <sub>DD_IO</sub> (for simultaneous ramp up/down), and no external 1.8 V supply shall be connected to V <sub>DD_CORE</sub> . In single supply mode, the maximum decoupling capacitance on V <sub>DD_CORE</sub> must not be more than 400 uF (well damped). In dual supply mode, V <sub>DD_LDO</sub> should be connected to V <sub>DD_CORE</sub> , and external 1.8 V supply connected to V <sub>DD_CORE</sub> .				
Note 11:	To maintain device long-term reliability, I <sub>DD_LDO</sub> of maximum 700 mA in average and maximum 1.1 A <sub>Peak</sub> repetitive pulse transients of maximum length in order of 100 us must be fulfilled. To guarantee full regulation performance of the LDO output voltage (V <sub>DD_CORE</sub> ), maximum 700 mA should be fulfilled. The LDO can supply external 1.8 V loads connected between V <sub>DD_CORE</sub> and GND on PCB, but these loads must not cause any violations of the above I <sub>DD_LDO</sub> limits, and must never back-feed any current into the LDO to maintain output voltage regulation and device long-term reliability.				
Note 12:	To maintain device long-term reliability, the pin must not be more than 3.6 V from any of its supply rails. Therefore, when pin voltage is at -0.1 V or V <sub>DD3V3</sub> +0.1 V, the supply voltage V <sub>DD3V3</sub> must not be higher than 3.5 V. For V <sub>GPIO</sub> , the GPIO port location determines when V <sub>DD3V3</sub> is V <sub>DD_IO</sub> or V <sub>DDA</sub> . For V <sub>LVDS_OUT</sub> , the V <sub>DD3V3</sub> is V <sub>DD_LVDS</sub> .				
Note 13:	There are no limitations on V <sub>ID</sub> in this range. Extended common mode range is supported in normal operation and cold-spare mode and during transition in-between modes. I.e., the LVDS inputs are also hot-swap compatible, and more than one LVDS input can be active and read across the same 100 Ω receiver termination resistor at the same time.				
Note 14:	To maintain device long-term reliability, maximum negative DC voltage on LVDS input pin is -3.6 V <sub>DC</sub> and transient peak is -4.0 V <sub>Peak</sub> up to 0.1% duty cycle over lifetime.				
Note 15:	V <sub>LVDS_OUT</sub> is applicable only in LVDS cold-spare mode (V <sub>DD_LVDS</sub> =-0.1V to 0.2V) and LVDS output-disable mode (V <sub>DD_LVDS</sub> =3.0V to 3.6V). It is not applicable during the transition V <sub>DD_LVDS</sub> =0.2V to 3.0V, where externally applied voltage other than GND onto the LVDS pins must be avoided. To maintain device long-term reliability, continuous operation at V <sub>DD_LVDS</sub> =0.2V to 3.0V is not allowed.				
Note 16:	Connect ceramic capacitor to ground, close to the pin with short wire, and not connected to anything else. For functional values see Section 57.11.				

# LEON3FT Microcontroller

 Table 725. Recommended operating conditions <sup>1) 2)</sup>

Symbol	Parameter	Rating			Units
		Min.	Typ.	Max.	
Note 17:	For functional configurations of the internal XO, see chapter 9. To maintain device long-term reliability, a correct value of $R_{X2}$ must be inserted when applicable, see section 9.2.3.				
Note 18:	Outside this frequency range, internal clock detection may switch the internal system clock unconditionally to the external system clock input (pin 57). To use $f_{intsys} < 5$ MHz, the frequency should be fed into pin 57 and configured to be used as the internal system clock. See chapter 4 for clock muxing and configurations.				
Note 19:	For functional configurations, see chapter 10 for supported PLL input frequencies and chapter 33 for the SpaceWire interface.				

## 57.3 Power supply characteristics

 Table 726. DC characteristics <sup>1)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$I_{DD\_CORE}$	Core Supply current	$f_{intsys} = 10$ MHz <sup>2) 3)</sup>		60	TBD	mA
		$f_{intsys} = 100$ MHz <sup>2) 3)</sup>		600	TBD	mA
$I_{DD\_LDO}$	LDO Supply current	$f_{intsys} = 10$ MHz <sup>2) 3)</sup>		60	TBD	mA
$I_{DD\_IO}$	I/O Supply current	$f_{intsys} = 100$ MHz <sup>2) 3) 4)</sup> Excluding I/O output current. PLL, ADC and ACOMP disabled. LVDS ports (pin 77-80) enabled.		20	TBD	mA
		I/O and LVDS ports (pin 77-80), PLL, ADC and ACOMP disabled.		0.1	TBD	mA
$I_{DDA\_PLL}$	PLL Supply current	Internally supplied from $V_{DD\_IO}$		10	TBD	mA
$I_{DDA} + I_{DD\_IO\_ANA}$	Sum of Analog Supply currents	Analog functions operational: $4xI_{DAC} + 4xI_{ADC} + 20xI_{ACOMP} + I_{REF}$ Excluding I/O and $V_{RefBuf}$ output current.		70	TBD	mA
$I_{DD\_LVDS}$	LVDS I/O Supply current	Operational <sup>4)</sup>		40	TBD	mA
		Shutdown <sup>4)</sup>		0.01	TBD	mA

Note 1: Recommended operating conditions, see chapter 57.2

Note 2: Digital user scenario with CAN and SpaceWire running at full data rate.

Note 3: LEON3 and 2xRTA running 100% (with frequent memory access), and internal SpaceWire clock at 100 MHz.

Note 4: Valid signals applied on LVDS inputs, and 100  $\Omega$  differential terminations on LVDS outputs. Valid signals applied on CMOS inputs, and no external load on CMOS outputs.

# LEON3FT Microcontroller

## 57.4 Simplified schematics for IO buffers

Simplified input and output buffer schematics presented in this chapter are applicable within absolute maximum rating conditions, see chapter 57.1

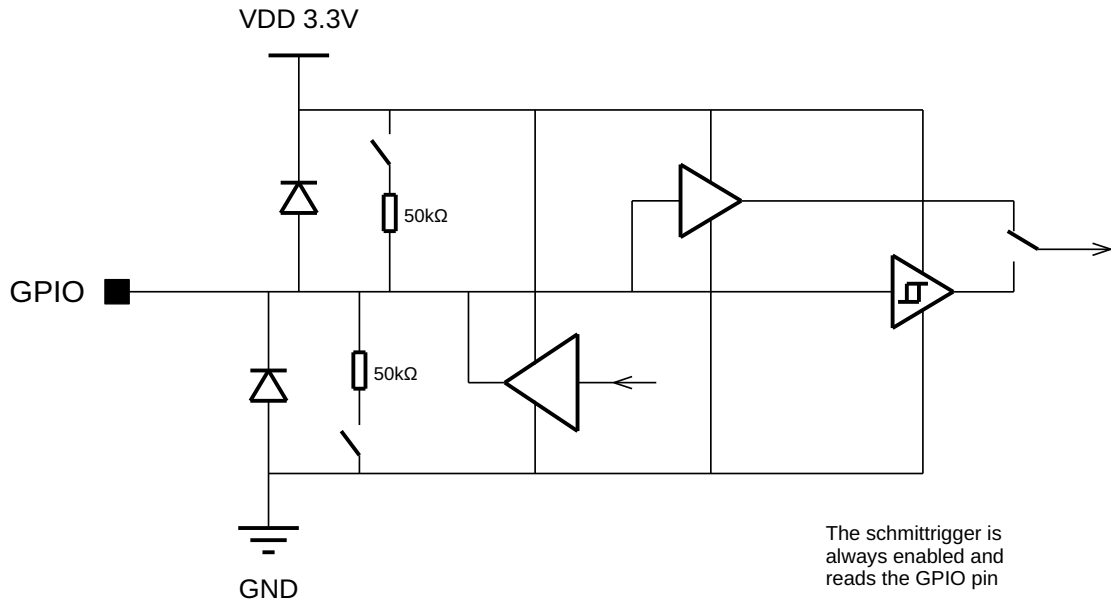


Figure 135. Simplified schematic of Bidirectional Digital GPIO buffer

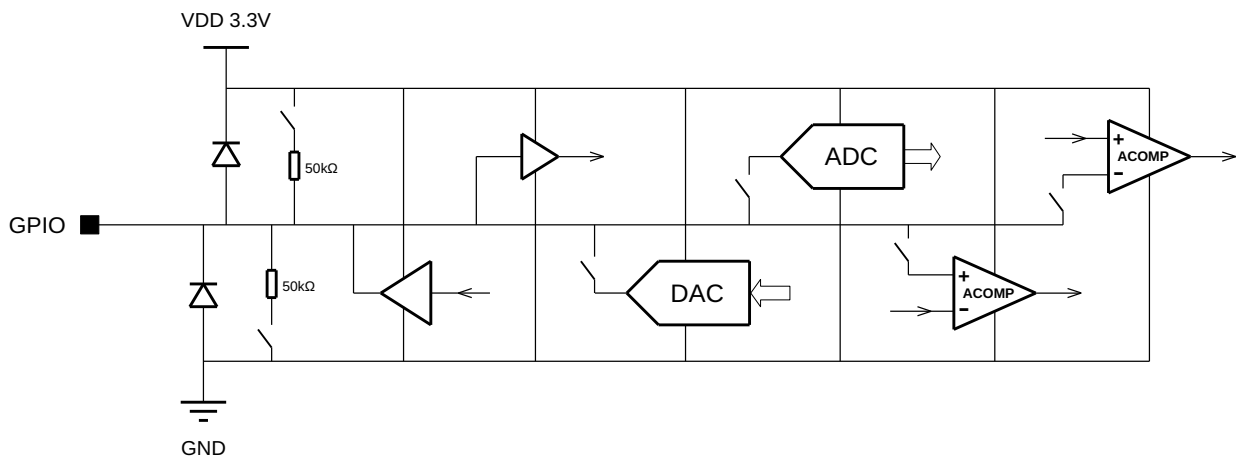


Figure 136. Simplified schematic of Bidirectional GPIO buffer with Analog capabilities

# LEON3FT Microcontroller

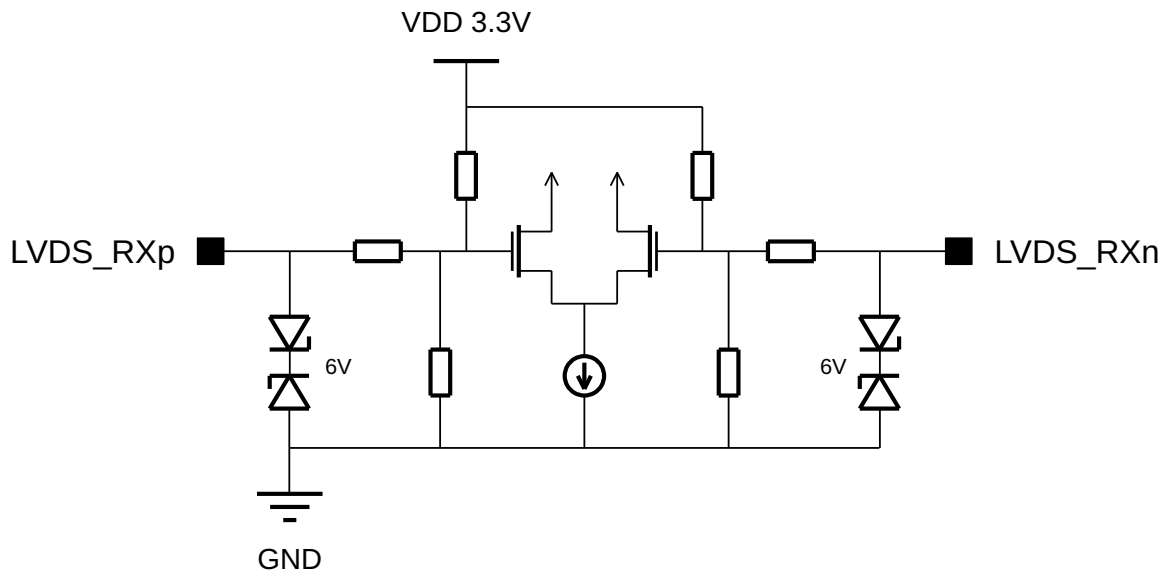


Figure 137. Simplified schematic of LVDS input buffer with Cold-Spare support

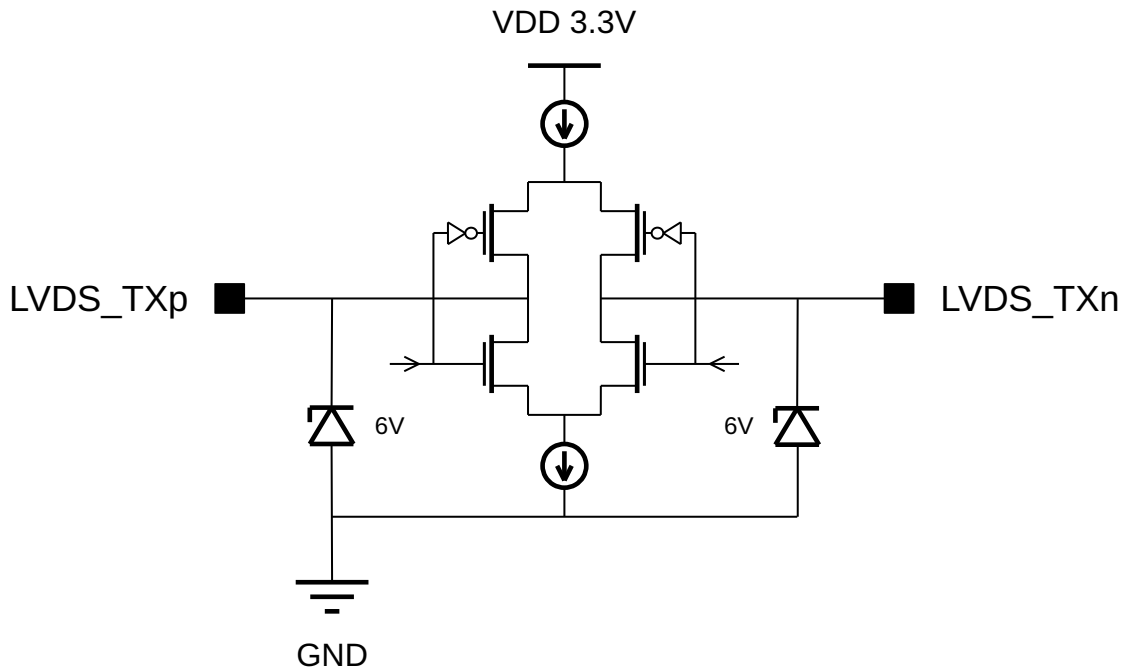


Figure 138. Simplified schematic of LVDS output buffer with Cold-Spare support

# LEON3FT Microcontroller

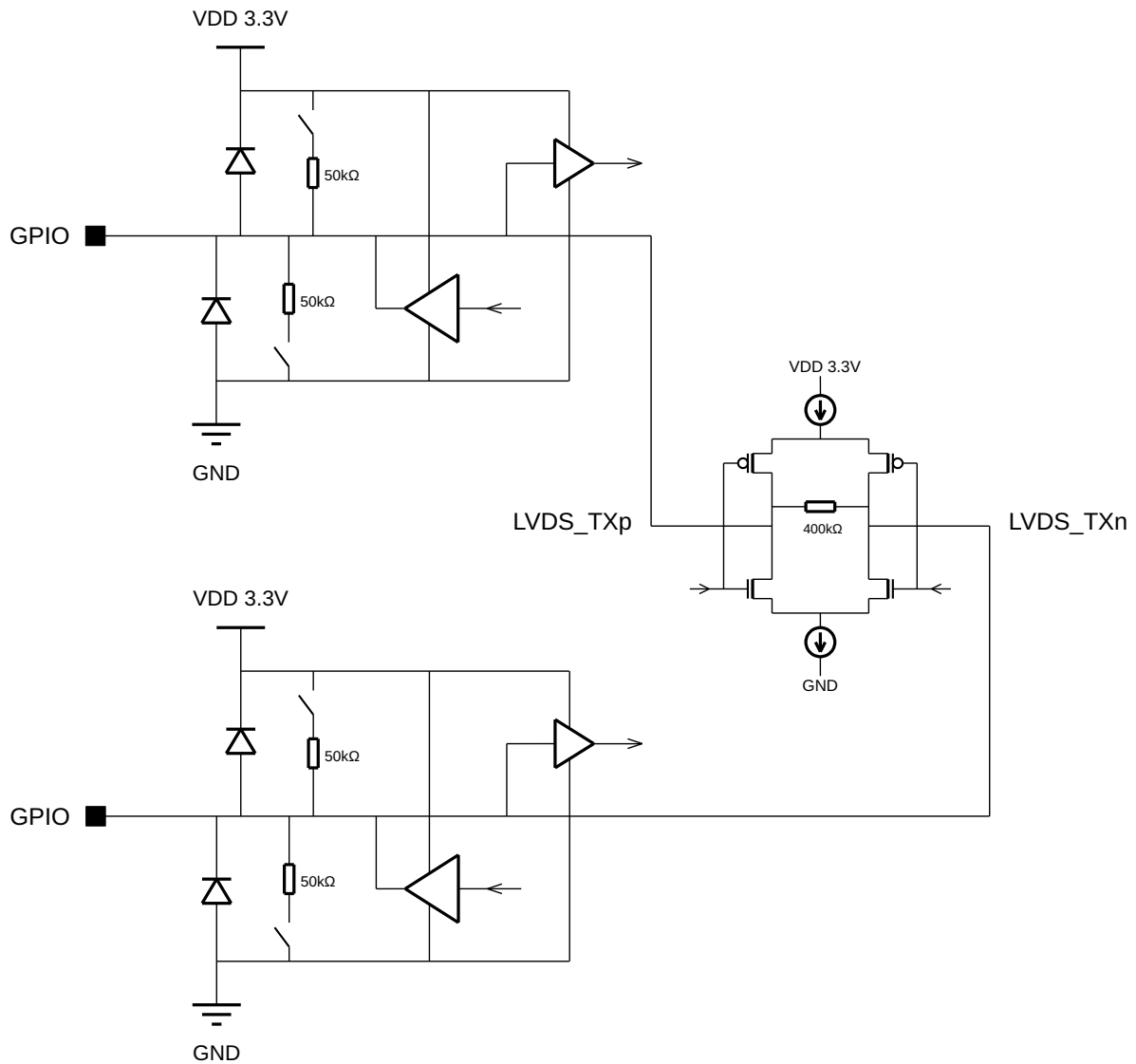


Figure 139. Simplified schematic of 2xGPIO with LVDS non-cold-spare output buffer



# LEON3FT Microcontroller

## 57.5 Input voltages, leakage currents and capacitances

 Table 727. DC characteristics for CMOS inputs <sup>1)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
V <sub>IH</sub>	Input High Voltage CMOS		0.67x V <sub>DD_IO</sub>			V
V <sub>IL</sub>	Input Low Voltage CMOS				0.27x V <sub>DD_IO</sub>	V
V <sub>IH_SCH</sub> <sup>9)</sup>	Input High Voltage Schmitt trigger		0.75x V <sub>DD_IO</sub>			V
V <sub>IL_SCH</sub> <sup>9)</sup>	Input Low Voltage Schmitt trigger				0.23x V <sub>DD_IO</sub>	V
V <sub>I_HYST</sub>	Input Hysteresis Voltage Schmitt trigger		TBD	0.3	TBD	V
I <sub>I LEAK_1</sub> <sup>3)</sup>	Input Leakage Current GPIO	V <sub>IN</sub> = V <sub>DD_IO</sub>			3	uA
		V <sub>IN</sub> = 2.6 V <sup>10)</sup>	TBD		0.3	uA
		V <sub>IN</sub> = -0.1 V	-0.3			uA
I <sub>I LEAK_2</sub> <sup>3)</sup>	Input Leakage Current GPIO with int. pull down	V <sub>IN</sub> = V <sub>DD_IO</sub>			100	uA
		V <sub>IN</sub> = 0 V	-1			uA
I <sub>I LEAK_3</sub> <sup>3)</sup>	Input Leakage Current GPIO with int. pull up	V <sub>IN</sub> = V <sub>DD_IO</sub>			1	uA
		V <sub>IN</sub> = 0 V	-100			uA
I <sub>I LEAK_PUD</sub> <sup>3) 11)</sup>	Input Leakage Current during power up/down GPIO 0-36, 49-50, 63	V <sub>DD_IO</sub> = 0V-3.6V V <sub>DD_CORE</sub> = 0V-1.98V < V <sub>DD_IO</sub> V <sub>IN</sub> = -0.1V to V <sub>DD_IO</sub> +0.1V	-10 <sup>2)</sup>		10 <sup>2)</sup>	uA
		V <sub>DD_CORE</sub> = 0V-1.98V V <sub>DD_IO</sub> = V <sub>DD_CORE</sub> V <sub>IN</sub> = V <sub>DD_IO</sub> / 2	-10		10	uA
		V <sub>DD_CORE</sub> = 0V-1.98V V <sub>DD_IO</sub> = 3.0V, 3.6V V <sub>IN</sub> = V <sub>DD_IO</sub> / 2	-10		10	uA
		V <sub>DD_IO</sub> = 0V-3.6V V <sub>DD_LDO</sub> = V <sub>DD_IO</sub> V <sub>DD_CORE</sub> supplied by LDO V <sub>IN</sub> = V <sub>DD_IO</sub> / 2	-10		10	uA
I <sub>I LEAK_4</sub> <sup>4)</sup>	Input Leakage Current CMOS with int. pull down	V <sub>IN</sub> = V <sub>DD_IO</sub>			160	uA
		V <sub>IN</sub> = 0 V	-1			uA
I <sub>I LEAK_5</sub> <sup>5)</sup>	Input Leakage Current CMOS	V <sub>IN</sub> = V <sub>DD_IO</sub>			5	uA
		V <sub>IN</sub> = 0 V	-5			uA
I <sub>I LEAK_6</sub> <sup>6)</sup>	See Note 6					
I <sub>I LEAK_7</sub> <sup>7)</sup>	Input Leakage Current Internal pull down	V <sub>IN</sub> = V <sub>DD_IO</sub>			320	uA
		V <sub>IN</sub> = 0 V	-3			uA
I <sub>I LEAK_8</sub> <sup>8)</sup>	Input Leakage Current Internal pull up	V <sub>IN</sub> = V <sub>DD_IO</sub>			1	uA
		V <sub>IN</sub> = 0 V	-160			uA
C <sub>IO</sub>	Input Capacitance				5 <sup>2)</sup>	pF

Note 1: Recommended operating conditions, see chapter 57.2

# LEON3FT Microcontroller

 Table 727. DC characteristics for CMOS inputs <sup>1)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
Note 2:	Guaranteed by design. Not tested in production.					
Note 3:	GPIO port configured to HiZ/input mode, and programmable analog functions disabled.					
Note 4:	CLK, SPWCLK, DUART_RX, DSU_EN and DSU_BREAK input only.					
Note 5:	SPIM_SEL, SPIM_SCK and SPIM_MOSI input only.					
Note 6:	I <sub>LEAK_6</sub> is for RESET_IN_N input only, and it is presented in table 736.					
Note 7:	TESTEN input only.					
Note 8:	SPIM_MISO input only.					
Note 9:	Input pins with schmitt trigger are listed in table 760. The input voltage is allowed to be at any level from -0.1V to V <sub>DD_IO</sub> +0.1V continuously. When it is between V <sub>IL_SCH</sub> and V <sub>IH_SCH</sub> , the supply current, I <sub>DD_IO</sub> , is increased up to TBD mA per input. For GPIO ports to operate continuously in this input interval, the GPIO port must be configured to Analog mode. An input must not be more than 3.6 V from any of its supply rails to maintain device long-term reliability, so when it is at -0.1V or V <sub>DD_IO</sub> +0.1V, the supply voltage must not be higher than 3.5 V.					
Note 10:	Guaranteed by production measurement for GPIO 37-48 and 51-58. Guaranteed by design for the other GPIO ports.					
Note 11:	For I <sub>LEAK_PUD</sub> to be applicable, the V <sub>DD_CORE</sub> and V <sub>DD_IO</sub> maximum slewrate needs to be ±10 V/ms, and the GPIO port must be configured to HiZ/input mode. During power supply ramp up, this GPIO mode is guaranteed by the internal power-on reset. During supply ramp down it needs to be configured from User software before the ramp down starts, or at the latest in an interrupt routine triggered by the Brownout detector on V <sub>DD_CORE</sub> , V <sub>DD_IO</sub> or V <sub>DDA_REF</sub> (internal critical references), whichever that triggers its Brownout level first. Other Brownout detectors for critical supplies should also be included, such as for the PLL if the internal system clock comes from the PLL. Finally, also before supply ramp down, all software execution on GR716 should be suspended into halt state by clock gating, to avoid faulty register writings from erroneous execution when V <sub>DD_CORE</sub> falls below recommended operating conditions.					

 Table 728. Characteristics for LVDS inputs <sup>1)2)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
V <sub>TH</sub>	Differential positive threshold		5	35	80	mV
V <sub>TL</sub>	Differential negative threshold		-5	-35	-80	mV
V <sub>T_HYST</sub>	Differential threshold hysteresis		40	70	100	mV
V <sub>ID</sub>	Differential input magnitude	<u>Bitrate</u> 0.1 Mbit/s: 50 Mbit/s: 100 Mbit/s: 200 Mbit/s:	0.1 0.1 0.15 0.2		2.0 2.0 2.0 2.0	V
V <sub>ECMR</sub> <sup>4)</sup>	Extended common mode range	<u> V<sub>ID</sub> </u> 0.1 V : 2.0 V :	-3.95 <sup>5)</sup> -3.00 <sup>5)</sup>		4.95 4.00	V
I <sub>I_LVDS</sub>	Input current per pin	<u>V<sub>LVDS_IN</sub></u> 0V to 2.4V : -4.0V to 5.0V :	-20 -30 <sup>4)</sup>		20 30 <sup>4)</sup>	uA
I <sub>IB</sub>	Input balance current		-6		6	uA
C <sub>I_LVDS</sub>	Input capacitance per pin				5 <sup>3)</sup>	pF

# LEON3FT Microcontroller

Table 728. Characteristics for LVDS inputs <sup>1) 2)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$t_{fsa}$	Failsafe activation delay	$ V_{ID}  < 25 \text{ mV}$	100		1000	ns
$t_{fsd}$	Failsafe deactivation delay	$ V_{ID} $ goes to normal operation	5 <sup>3)</sup>		50 <sup>3)</sup>	ns
$SR_{ID}$	Differential slewrate		2 <sup>3) 6)</sup>			V/us

Note 1: Recommended operating conditions, see chapter 57.2

Note 2: Compliant to ANSI TIA/EIA-644 “Low Voltage Differential Signaling”

Note 3: Guaranteed by design. Not tested in production.

Note 4: Extended common mode range is supported in normal operation and cold-spare mode and during transition in-between modes. I.e., the LVDS inputs are also hot-swap compatible, and more than one LVDS input can be active and read across the same 100ohm receiver termination resistor at the same time.

Note 5: Maximum negative DC voltage per pin is  $-3.6 V_{DC}$  and transient peak is  $-4.0 V_{Peak}$  up to 0.1% duty cycle over lifetime, to maintain device longterm reliability.

Note 6: Limited by the failsafe activation delay.

# LEON3FT Microcontroller

## 57.6 Output voltages, leakage currents and capacitances

Table 729. DC characteristics for Digital CMOS outputs <sup>1)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -2.0 mA <sup>3)</sup>	V <sub>DD_IO</sub> - 0.5			V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.0 mA <sup>3)</sup>			0.4	V
I <sub>OLEAK</sub>	Output Leakage Current	Outputs at tri-state. V <sub>OUT</sub> = V <sub>DD_IO</sub> and V <sub>OUT</sub> = 0V	-10		10	uA
C <sub>IO</sub>	Output Capacitance				5 <sup>2)</sup>	pF

Note 1: Recommended operating conditions, see chapter 57.2

Note 2: Guaranteed by design. Not tested in production.

Note 3: Digital CMOS outputs have 2mA drive capability, except for DUART\_TX (pin 8) and XO\_OUT (pin 58) which have drive capability of and are tested at 4mA. See also Table 760.

Table 730. DC characteristics for LVDS outputs in the V<sub>DD\_LVDS</sub> supply domain <sup>1) 2)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
V <sub>OS</sub>	Offset voltage	4)	1.125	1.250	1.375	V
ΔV <sub>OS</sub>	Change in magnitude of V <sub>OS</sub> for complementary output states	4)	-50		50	mV
V <sub>OD</sub>	Absolute differential Output voltage	4)	250	350	450	mV
Δ V <sub>OD</sub>	Change in magnitude of  V <sub>OD</sub>   for complementary output states	4)	-50		50	mV
I <sub>OZ</sub> <sup>5)</sup>	Output leakage current when disabled	V <sub>LVDS_OUT</sub> = -0.1V to 3.6V V <sub>DD_LVDS</sub> = 3.0V to 3.6V	-2		2	uA
I <sub>OZ_OFF</sub> <sup>5)</sup>	Output leakage current in power off (cold-spare mode)	V <sub>LVDS_OUT</sub> = -0.1V to 3.6V V <sub>DD_LVDS</sub> = -0.1V to 0.2V	-2		2	uA
I <sub>OS</sub>	Short-circuit Output current			6	24	mA
I <sub>ODS</sub>	Differential short-circuit Output current			4	12	mA
C <sub>O_LVDS</sub>	Output capacitance per pin				5 <sup>3)</sup>	pF

Note 1: Recommended operating conditions, see chapter 57.2

Note 2: Compliant to ANSI TIA/EIA-644 “Low Voltage Differential Signaling”. The Symbols/Parameters are defined in this standard.

Note 3: Guaranteed by design. Not tested in production.

Note 4: LVDS outputs are terminated with 100Ω differentially.

# LEON3FT Microcontroller

Table 730. DC characteristics for LVDS outputs in the  $V_{DD\_LVDS}$  supply domain <sup>1)2)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	

Note 5: Applicable in LVDS cold-spare and output-disable mode, respectively, but not applicable *during supply transition* in-between these modes.

Table 731. DC characteristics for LVDS outputs on GPIO ports <sup>1)2)3)</sup>

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$V_{OS}$	Offset voltage	5)	1.125	1.250	1.375	V
$\Delta V_{OS}$	Change in magnitude of $V_{OS}$ for complementary output states	5)	-50		50	mV
$ V_{OD} $	Absolute differential Output voltage	5)	250	350	450	mV
$\Delta V_{OD} $	Change in magnitude of $ V_{OD} $ for complementary output states	5)	-50		50	mV
$I_{OZ}$	Output leakage current when disabled	6)	-2		2	$\mu$ A
$I_{OS}$	Short-circuit Output current				24	mA
$I_{ODS}$	Differential short-circuit Output current				12	mA
$C_{O\_LVDS}$	Output capacitance per pin				5 <sup>4)</sup>	pF

Note 1: Recommended operating conditions, see chapter 57.2

Note 2: Compliant to ANSI TIA/EIA-644 “Low Voltage Differential Signaling”. The Symbols/Parameters are defined in this standard.

Note 3: These LVDS outputs are non-cold-spare ports. The LVDS output pin voltage must be between GND and  $V_{DD\_IO}$ , otherwise the on-chip ESD protection diodes will conduct current.

Note 4: Guaranteed by design. Not tested in production.

Note 5: LVDS outputs are terminated with 100  $\Omega$  differentially.

Note 6: Each LVDS pair is internally connected with a differential resistor (~400 k $\Omega$ ). The given output leakage currents only apply with the opposite LVDS output terminal floating.

# LEON3FT Microcontroller

## 57.7 DAC Electrical Characteristics

Table 732. Electrical characteristics for DAC outputs

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
	Resolution			12		Bit
$f_S$	Sampling rate	Full analog performance: Full functionality: $f_S$ is user programmable ( $f_{intsys}$ divided by integer).			3 <sup>1)3)</sup> 25 <sup>3)</sup>	MSps
FS	Fullscale current	$I_{Rref} = V_{ref}/R_{ref} = 1.000V/5.11k\Omega$		4.00		mA
FS <sub>ERR</sub>	Fullscale error	Excluding V <sub>ref</sub> and R <sub>ref</sub> tolerances	-1		1	%
I <sub>OFFS</sub>	Offset current		-0.5		0.5	LSB
INL	Integral non-linearity	With DEM: Without DEM:			2 <sup>2)</sup> 3 <sup>2)</sup>	LSB
DNL	Differential non-linearity	With DEM: Without DEM:			1 <sup>2)</sup> 1.5 <sup>2)</sup>	LSB
V <sub>OUT</sub>	Compliance voltage		-0.1 <sup>5)</sup>		V <sub>DDA</sub> 0.7 <sup>4)</sup>	V
PSRR	Power supply rejection ratio	V <sub>DDA</sub> = 3.3V <sub>DC</sub> ± 0.3V <sub>DC</sub> : V <sub>DDA</sub> = 20mV <sub>pp</sub> , 100kHz:			1 <sup>1)</sup> 1 <sup>1)</sup>	uA <sub>pp</sub>
I <sub>OUT_SD</sub>	Output leakage current	Shutdown. V <sub>OUT</sub> = -0.1V to 2.6V		0.01	0.5	uA
I <sub>DDA</sub>	Current consumption per DAC	Operational, $f_S=25MSps$ , with DEM: Shutdown:		5 0.001	7 0.01	mA
V <sub>DDA</sub>	Supply voltage		3.0		3.6	V

Note 1: Guaranteed by design. Not tested in production.

Note 2: A 1 nF ceramic capacitor to V<sub>SSA\_DAC</sub> placed very close to the GPIO pin is required. It will low-pass filter charge ejection from the internal DAC current switching, which is especially important in the continuously switching DEM mode. These parameters are tested in production at TBD MSps, at V<sub>OUT</sub> = -0.1 V and V<sub>DDA</sub>-0.7 V.

Note 3: Max 3MSps, with load impedance to ground of 500 Ω and 100 pF, give large-signal settling to 0.1%. Max 25MSps is allowed on DAC digital input, which may not give full analog settling between samples but can give smoother waveforms when generating analog ramps, etc.

Note 4: Analog performance not guaranteed for V<sub>OUT</sub>>2.6 V.

Note 5: The DAC output voltage must not be more than 3.6 V from any of its supply rails, to maintain device long-term reliability. When output voltage is -0.1 V, the supply voltage must not be higher than 3.5 V.

# LEON3FT Microcontroller

## 57.8 ADC Electrical Characteristics

Table 733. Electrical characteristics for ADC inputs

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
	Resolution	User programmable conversion mode  Mode 0: Mode 1: Mode 2: Mode 3:  Differential and Single-ended analog input mode.		11 12 <sup>2)</sup> 13 <sup>2)</sup> 14 <sup>2)</sup>		Bit
$f_s$	Sampling rate	Mode 0: Mode 1: Mode 2: Mode 3:  One MUX input channel at a time. * At minimum $t_{track}$ and $t_{conv}$			500 * 312 * 128 * 80 *	kSps
$f_{adc,clk}$	Clock input frequency	User programmable ( $f_{intsys}$ divided by integer).			10	MHz
$t_{track}$	Track time	Mode 0: Mode 1: Mode 2: Mode 3:	0.6 0.8 0.8 0.8		400 <sup>1)3)</sup> 50 <sup>1)3)</sup> 50 <sup>1)3)</sup> 50 <sup>1)3)</sup>	us
$t_{conv}$	Conversion time excluding track time	Mode 0: Mode 1: Mode 2: Mode 3:  * At maximum $f_{adc,clk}$	1.4 * 2.4 * 7.0 * 11.6 *		200 <sup>1)4)</sup> 25 <sup>1)4)</sup> 25 <sup>1)4)</sup> 25 <sup>1)4)</sup>	us
$I_{DD}^{6)}$	Current consumption per ADC, including pre-amplifier	Shutdown		0.1	10	uA
$V_{DD}^{6)}$	Supply voltage		3.0		3.6	V
<b>Single-ended analog input (always without pre-amplifier)</b>						
FS	Fullscale	Vref=1.000V  $V_{SSA\_REF}$ is reference for ADC 0-2. GND is reference for ADC 3.		2.5		V
FS <sub>ERR</sub>	Fullscale error	Excluding Vref tolerances	-0.5		0.5	%
$V_{INOFFS}$	Offset voltage	Mode 0: Mode 1: Mode 2: Mode 3:	-1 TBD TBD TBD		1 TBD TBD TBD	LSB
INL	Integral non-linearity	Mode 0: Mode 1: Mode 2: Mode 3:			1.5 TBD TBD TBD	LSB
DNL	Differential non-linearity	Mode 0: Mode 1: Mode 2: Mode 3:			1 1 1 1	LSB

# LEON3FT Microcontroller

Table 733. Electrical characteristics for ADC inputs

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$ I_{IN,LEAK} $	Input leakage current	$V_{IN} = -0.1V$ to $2.6V$		0.01	0.3	$\mu A$
$C_{IN}$	Input capacitance	Unselected channel: Selected channel during Track:		28	5 <sup>1)</sup> 35 <sup>1)</sup>	pF
PSRR <sup>6)</sup>	Power supply rejection ratio	$V_{DD} = 3.3V_{DC} \pm 0.3V_{DC}$ : $V_{DD} = 20mV_{pp}, 100kHz$ :			1 <sup>1)</sup> 1 <sup>1)</sup>	mV
$I_{DD}^{6)}$	Current consumption per ADC, excluding pre-amplifier	Operating at $f_{S,max}$ and $f_{adc,clk,max}$		8	TBD	mA
<b>Differential analog input, without pre-amplifier</b>						
$FS_{diff}$	Fullscale	$V_{ref}=1.000V$		$\pm 2$		V
$FS_{diff,ERR}$	Fullscale error	Excluding $V_{ref}$ tolerances	-0.5		0.5	%
$V_{INOFFS}$	Offset voltage	Mode 0: Mode 1: Mode 2: Mode 3:	-1.5 TBD TBD TBD		1.5 TBD TBD TBD	LSB
INL	Integral non-linearity	Mode 0: Mode 1: Mode 2: Mode 3:			1.5 TBD TBD TBD	LSB
DNL	Differential non-linearity	Mode 0: Mode 1: Mode 2: Mode 3:			1 TBD TBD TBD	LSB
$ I_{IN,LEAK} $	Input leakage current per pin	$V_{IN} = -0.1V$ to $2.6V$		0.01	0.3	$\mu A$
$C_{IN}$	Input capacitance per pin	Unselected channel: Selected channel during Track:		28	5 <sup>1)</sup> 35 <sup>1)</sup>	pF
CMRR <sup>6)</sup>	Common mode rejection ratio	$V_{in+}$ and $V_{in-}$ within $-0.1V$ to $V_{DD}+0.1V$ . Common mode TBD $20mV_{pp}, 100kHz$			1 <sup>1)</sup> 1 <sup>1)</sup>	mV
PSRR <sup>6)</sup>	Power supply rejection ratio	$V_{DD} = 3.3V_{DC} \pm 0.3V_{DC}$ : $V_{DD} = 20mV_{pp}, 100kHz$ :			1 <sup>1)</sup> 1 <sup>1)</sup>	mV
$I_{DD}^{6)}$	Current consumption per ADC, excluding pre-amplifier	Operating at $f_{S,max}$ and $f_{adc,clk,max}$		8	TBD	mA
<b>Pre-amplifier differential analog input (used with ADC differential mode)</b>						
$G_{PreAmp}$	Gain of Pre-Amp	Gain x1 Gain x2 Gain x4		1 2 4		
$G_{PA,ERR}$	Gain error of Pre-Amp	Independent error per input channel	-0.5 <sup>1)</sup>		0.5 <sup>1)</sup>	%
$V_{PA,OFFS}$	Input offset voltage of pre-amp, excluding ADC offset.	Gain x1 Gain x2 Gain x4	-0.5 <sup>1)</sup> -0.5 <sup>1)</sup> -0.5 <sup>1)</sup>		0.5 <sup>1)</sup> 0.5 <sup>1)</sup> 0.5 <sup>1)</sup>	mV



# LEON3FT Microcontroller

Table 733. Electrical characteristics for ADC inputs

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$R_{IN,DM}$	Input resistance, differential mode, for selected channel during Track.	Gain x1 Gain x2 Gain x4		84 56 33		k $\Omega$
$R_{IN,CM}$	Input resistance, common mode, for selected channel during Track.	Gain x1 Gain x2 Gain x4		84 <sup>5)</sup>		k $\Omega$
$C_{IN}$	Input capacitance per pin				5 <sup>1)</sup>	pF
CMR <sup>6)</sup>	Input common mode range	Gain x1	TBD		TBD	V
		Gain x2	TBD		TBD	
		Gain x4	TBD		TBD	
CMRR <sup>6)</sup>	Input-referred common mode rejection ratio	Within full CMR <sub>DC</sub> :			1 <sup>1)</sup>	mV
		20mV <sub>pp</sub> , 100kHz:			1 <sup>1)</sup>	
PSRR <sup>6)</sup>	Input-referred power supply rejection ratio	V <sub>DD</sub> = 3.3V <sub>DC</sub> ±0.3V <sub>DC</sub> :			1 <sup>1)</sup>	mV
		V <sub>DD</sub> = 20mV <sub>pp</sub> , 100kHz:			1 <sup>1)</sup>	
I <sub>DD</sub> <sup>6)</sup>	Current consumption per ADC, including pre-amplifier	Operating at f <sub>S,max</sub> and f <sub>adc,clk,max</sub>		10	TBD	mA

Note 1: Guaranteed by design. Not tested in production.

Note 2: This conversion mode provides single event transient (SET) detection status flag.

Note 3: This is maximum track time in pre-amplifier mode to maintain full accuracy up to 110°C. At 125°C, performance degradation of hundreds of microvolt may be expected, but maximum track time can be shortened a factor of two or preferably three to minimize this degradation. In by-pass mode, there is no maximum track time limit.

Note 4: This is maximum ADC conversion time, excluding track time, to maintain full accuracy up to 110°C. At 125°C, performance degradation of a couple of LSB may be expected, but maximum conversion time can be shortened a factor of two or preferably three to minimize this degradation.

Note 5: CM impedance is defined as small-signal current per input pin, when applying CM small-signal voltage. The internal CM termination DC voltage is 1.5 V.

Note 6: Supply voltage, V<sub>DD</sub>, for ADC 0-2 is V<sub>DDA\_ADC</sub> vs V<sub>SSA\_ADC</sub>, and for ADC 3 it is V<sub>DD\_IO</sub> vs GND.

# LEON3FT Microcontroller

## 57.9 Analog Comparator Electrical Characteristics

Table 734. Electrical characteristics for Analog Comparator inputs

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$V_{IN,SW}$	Differential input voltage for output switching	Including offset and hysteresis	-13	+/-4	13	mV
$V_{IN,HYST}$	Differential input hysteresis		5	8	11	mV
$t_{resp}$	Response time	<u>Fast mode</u>				ns
		Differential overdrive 50mV:	7	12	18	
		Differential overdrive 15mV:	15	30	45	
		<u>Disturbance tolerant mode</u>				
	Differential overdrive 50mV:	35	55	80		
	Differential overdrive 15mV:	45	70	95		
$t_{rej}$	Pulse rejection time	<b>Disturbance tolerant mode.</b> <u>Differential square pulse</u> -50mV → 1V → -50mV 50mV → -1V → 50mV	20	35	50	ns
$ I_{IN,LEAK} $	Input leakage current per pin	Input voltage per pin -0.1V to 2.6V		0.01	0.3	uA
$C_{IN}$	Input capacitance per pin				5 <sup>1)</sup>	pF
CMR <sup>3)</sup>	Input common mode range		-0.1 <sup>2)</sup>		$V_{DD}$ -0.9 <sup>2)</sup>	V
CMRR <sup>3)</sup>	Input common mode rejection ratio		30 <sup>1)</sup>			dB
PSRR <sup>3)</sup>	Power supply rejection ratio		30 <sup>1)</sup>			dB
$I_{DD}$ <sup>3)</sup>	Current consumption per comparator	Operational:		400	500	uA
		Shutdown:		0.01	1	
$V_{DD}$ <sup>3)</sup>	Supply voltage		3.0		3.6	V

Note 1: Guaranteed by design. Not tested in production.

Note 2: One comparator input outside CMR, with the other input inside CMR or outside in opposite direction, will still guarantee correct comparator functionality, guaranteed by design not tested in production. An input that is more than 0.1V outside its supply rails does not guarantee electrical characteristics such as leakage current. The input is not allowed to be more than 3.6V from any of its supply rails to maintain device long-term reliability. If any input is subjected to repetitive current pulses through any of its on-chip ESD diodes, schottky diode(s) from the input to the supply rail(s) is needed.

Note 3: Supply voltage,  $V_{DD}$ , for comparator 0-11 is  $V_{DDA\_ADC}$  vs  $V_{SSA\_ADC}$ , and for comparator 12-19 it is  $V_{DD\_IO}$  vs GND.

## 57.10 Reference Voltages and Currents Electrical Characteristics

Table 735. Reference Voltages and Currents Electrical characteristics

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
V <sub>refDC</sub>	Reference voltage	Room temperature	0.980 <sup>7)</sup>	1.008	1.035 <sup>7)</sup>	V
		10 - 85 °C	-0.5 <sup>1)</sup>		0.5 <sup>1)</sup>	%
		-55 - 110 °C	-1 <sup>7)</sup>		1 <sup>7)</sup>	
		Aging drift <sup>4)</sup>	-0.2 <sup>5)</sup>		0.2 <sup>5)</sup>	
		TID drift	-0.3 <sup>6)</sup>		0.3 <sup>6)</sup>	
V <sub>refNoise</sub>	Reference noise	Integrated noise. 4.7nF on V <sub>ref</sub> pin to V <sub>SSA_REF</sub>		20		uV <sub>rms</sub>
PSRR <sub>Vref</sub>	Power supply rejection ratio	V <sub>DDA</sub> = 3.3V <sub>DC</sub> ±0.3V <sub>DC</sub> : V <sub>DDA</sub> = 20mV <sub>pp</sub> , 100kHz:			0.6 <sup>1)</sup> 1 <sup>1)</sup>	mV <sub>pp</sub>
I <sub>Rref</sub>	Reference current	5.11kΩ <sub>typ</sub> on R <sub>ref</sub> pin to V <sub>SSA_REF</sub> I <sub>Rref,typ</sub> = V <sub>refDC,typ</sub> / R <sub>ref,typ</sub>	2)	197	2)	uA
t <sub>start</sub>	Start-up time, after V <sub>DDA</sub> is operational	4.7nF on V <sub>ref</sub> pin to V <sub>SSA_REF</sub>		0.2	0.5 <sup>1)</sup>	ms
<b>Reference buffer output</b>						
V <sub>refbufGain</sub>	Reference buffer gain	V <sub>refbuf</sub> output voltage = V <sub>refbufGain</sub> × V <sub>ref</sub>		1.9		
		Tolerance at room temperature	-0.3 <sup>1) 7)</sup>		0.3 <sup>1) 7)</sup>	%
		Total tolerance over -55 - 110 °C	-0.5 <sup>1) 7)</sup>		0.5 <sup>1) 7)</sup>	
ΔV <sub>refbuf</sub>   <sub>Load</sub>	Output load regulation	ΔI <sub>refbuf</sub>   = 1mA <sub>DC</sub> and  dI <sub>refbuf</sub> /dt  < 0.1mA/us			0.1 <sup>1)</sup>	mV
V <sub>refbufNoise</sub>	Output noise	Integrated noise. 4.7nF on V <sub>ref</sub> pin to V <sub>SSA_REF</sub>		150		uV <sub>rms</sub>
I <sub>refbuf</sub>	Output sourcing current		-1		20	mA
t <sub>settling</sub> <sup>3)</sup>	Output settling time	<u>Residual settling voltage</u> 1 mV : 0.1 mV :			2 <sup>1)</sup> 3 <sup>1)</sup>	us
<b>ACOMP internal reference levels (supplied by ADC supply domain)</b>						
V <sub>refACOMP-Gain</sub>	ACOMP reference voltage levels (x7)	V <sub>refACOMP</sub> reference voltage = V <sub>refACOMPGain</sub> × V <sub>ref</sub>		0 0.125 0.25 0.5 1 1.5 2		
		Tolerance at room temperature	-0.3 <sup>1) 7)</sup>		0.3 <sup>1) 7)</sup>	%
		Total tolerance over -55 - 110 °C	-0.5 <sup>1) 7)</sup>		0.5 <sup>1) 7)</sup>	
<b>Power supply for Reference generation and Reference buffer amplifier</b>						
I <sub>DDA_REF</sub>	Current consumption	Excluding V <sub>refbuf</sub> output current		2	4	mA
V <sub>DDA_REF</sub>	Supply voltage		3.0		3.6	V

Note 1: Guaranteed by design. Not tested in production.

Note 2: Determined by the total tolerance spread of R<sub>ref</sub> pin external resistor and V<sub>ref</sub>.

# LEON3FT Microcontroller

Table 735. Reference Voltages and Currents Electrical characteristics

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
Note 3:	Settling after start-up from power down, after fast load step of $ \Delta I_{refbuf}  < 21 \text{ mA}$ , or after other environmental transient disturbances. The transient disturbance peak voltage may be in the order of $1 V_{Peak}$ . After LP filter on PCB of $330 \Omega_{min}$ and $120 \text{ nF}_{min}$ , or $470 \Omega_{nom}$ and $100 \text{ nF}_{nom}$ , the environmental disturbance transients should be $< 1 \text{ mV}_{Peak}$ . After LP filter of $330 \Omega_{min}$ and $1.2 \mu\text{F}_{min}$ , or $470 \Omega_{nom}$ and $1 \mu\text{F}_{nom}$ , they should be $< 0.1 \text{ mV}_{Peak}$ .					
Note 4:	4000 hours at $125^\circ\text{C}$ and $V_{DDA\_REF} = 3.6 \text{ V}$					
Note 5:	Start of aging drift is applicable after 240 hours burn-in at $125^\circ\text{C}$ . Without burn-in, the aging drift can be $-1.2\% / +0.4\%$ .					
Note 6:	Total Ionizing Dose (TID) test to $100 \text{ krad(Si)}$ . For $300 \text{ krad(Si)}$ the drift can be $-0.5\% / +0.5\%$ .					
Note 7:	$V_{refDC}$ is verified in production by measurement on $V_{refbuf}$ output (at $I_{refbuf}=0$ ).					

# LEON3FT Microcontroller

## 57.11 Reset and Brownout Detector Electrical Characteristics

The on-chip power on reset generator creates a reset signal that is fed to the rest of the system. This reset signal, POR\_INT\_N, is asynchronous. It activates the internal reset and has a delayed release controlled by an external capacitance, C\_RST. The POR\_INT\_N and RESET\_IN\_N are logically *and* gated, and generates internal reset, which is synchronously released after this delay.

Table 736. Reset Electrical Characteristics

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$t_{\text{RLS}}$ <sup>2) 3) 4)</sup>	Release delay, for internal power-on reset signal POR_INT_N	$C_{\text{RST}} = 0$ : $C_{\text{RST}} = 1 \text{ nF}$ : $C_{\text{RST}} = 100 \text{ nF}$ : The delay starts at $V_{\text{DD,RST,TH}}$ crossing during $V_{\text{DD\_CORE}}$ ramp up.	0.2 20	0.1 0.5 50	1.4 140	ms
$t_{\text{RSP}}$ <sup>1)</sup>	Response delay, for internal power-on reset signal POR_INT_N	$C_{\text{RST}} = 0$ : $C_{\text{RST}} = 1 \text{ nF}$ : $C_{\text{RST}} = 100 \text{ nF}$ : The delay starts at $V_{\text{DD,RST,TL}}$ crossing during $V_{\text{DD\_CORE}}$ ramp down.		1 10 30		us
$V_{\text{DD,RST,TH}}$	Reset high threshold for $V_{\text{DD\_CORE}}$ <sup>5)</sup>		1.2	1.4	1.6	V
$V_{\text{DD,RST,TL}}$	Reset low threshold for $V_{\text{DD\_CORE}}$ <sup>5)</sup>		1.1	1.3	1.5	V
$V_{\text{DD,RST,HYST}}$	Reset hysteresis for $V_{\text{DD\_CORE}}$ <sup>5)</sup>		50	100	150	mV
$V_{\text{IN,RST,TH}}$	Input high threshold for RESET_IN_N <sup>6)</sup>	$V_{\text{DD\_CORE}}$ according to table 725	0.5	0.9	1.3	V
$V_{\text{IN,RST,TL}}$	Input low threshold for RESET_IN_N <sup>6)</sup>	$V_{\text{DD\_CORE}}$ according to table 725	0.4	0.7	1.0	V
$V_{\text{IN,RST,HYST}}$	Input hysteresis for RESET_IN_N <sup>6)</sup>	$V_{\text{DD\_CORE}}$ according to table 725	50	200	350	mV
$I_{\text{LEAK}_6}$	Input leakage for RESET_IN_N <sup>6)</sup>	$V_{\text{IN}} = V_{\text{DD\_IO}}$ : $V_{\text{IN}} = 0 \text{ V}$ :	5 -30		30 -5	uA
$I_{\text{DD}}$	Current consumption			150	350	uA
$V_{\text{DD\_CORE}}$	Supply voltage and reset detection voltage		-0.1		2.0	V

Note 1: Guaranteed by design. Not tested in production.

Note 2: For power-on reset to function properly with specified release delay,  $t_{\text{RLS}}$ , first  $V_{\text{DD\_CORE}}$  must be discharged and stay below 0.2 V for at least a time of  $t_{\text{RLS,min}}$ .

Note 3: Production tested in dual and single supply mode. In single supply mode, tested for default setting of internal LDO.

# LEON3FT Microcontroller

The on-chip power on reset generator creates a reset signal that is fed to the rest of the system. This reset signal, POR\_INT\_N, is asynchronous. It activates the internal reset and has a delayed release controlled by an external capacitance, C\_RST. The POR\_INT\_N and RESET\_IN\_N are logically *and* gated, and generates internal reset, which is synchronously released after this delay.

Table 736. Reset Electrical Characteristics

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	

- Note 4: Reset timing external capacitor, C\_RST, must be large enough to keep the device in reset until all power supplies and the system clock are stable. The reset release time, t\_RLS, can be estimated by:  

$$t_{RLS,typ} = 0.5 \text{ ms/nF} \cdot C_{RST}$$
 For example  $t_{RLS,100nF} = 0.5 \text{ ms/nF} \cdot 100 \text{ nF} = 50 \text{ ms}_{typ}$ . There is no maximum limit for C\_RST value, but the required discharge time will increase proportionally, see t\_RLS,min in Note 2. If C\_RST pin would be left open, i.e., C\_RST=0, then t\_RLS will be in the order of 0.1 ms, but that is not recommended due to disturbance risk from other PCB circuitry. Therefore it is recommended to always connect at least 1 nF to this pin.
- Note 5: The reset threshold for V\_DD\_CORE is generated by an independent voltage reference in this internal power-on reset block.
- Note 6: The RESET\_IN\_N input pin is 3.6 V tolerant, and has no ESD protection diode to any positive supply. It has weak pull-up of 100 kΩ to V\_DD\_CORE.

Table 737. Characteristics for 1.8 V Brownout Detector

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
V_TH <sup>2)</sup>	Threshold	Settings in 25mV steps				V
		000		1.600		
		111		1.775		
	Threshold Detector	-1 <sup>1)</sup>		1 <sup>1)</sup>	%	
	Initial tol. at room temp. for Vref :		-3 <sup>1)3)</sup>		3 <sup>1)3)</sup>	
	Drift over full temp. for Vref :		-1 <sup>1)3)</sup>		1 <sup>1)3)</sup>	
t_RSP	Response time		2 <sup>1)</sup>		30 <sup>1)</sup>	us
I_DD	Current consumption per Brownout block	Operational: Shutdown:		25 0.01	50 1	uA
V_DD_BO	Supply voltage and Brownout detection voltage		1.5		2.0	V

- Note 1: Guaranteed by design. Not tested in production.
- Note 2: All Brownout Detectors use the Vref pin reference to generate the trig thresholds, so the Vref tolerances are to be added to the threshold detector tolerance. Also the internal LDOs for V\_DD\_CORE and V\_DDA\_PLL use the Vref pin reference. This means that the Vref tolerances are common for the Brownout Detectors and V\_DDA\_PLL, and for V\_DD\_CORE in single-supply mode. Hence, tolerance or drift of Vref will not give Brownout trig or affect any trig voltage margins.
- Note 3: Vref\_DC is verified in production by measurement on Vrefbuf output.

# LEON3FT Microcontroller

Table 738. Characteristics for 3.3V Brownout Detector

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$V_{TH}^{2)}$	Threshold	Settings in 50 mV steps				V
		000		2.90		
		111		3.25		
		Threshold Detector	-1 <sup>1)</sup>		1 <sup>1)</sup>	%
Initial tol. at room temp. for Vref :	-3 <sup>1)3)</sup>		3 <sup>1)3)</sup>			
Drift over full temp. for Vref :	-1 <sup>1)3)</sup>		1 <sup>1)3)</sup>			
$t_{RSP}$	Response time		2 <sup>1)</sup>		30 <sup>1)</sup>	us
$I_{DD}$	Current consumption per Brownout block	Operational:		50	100	uA
		Shutdown:		0.01	1	
$V_{DD\_BO}$	Supply voltage and Brownout detection voltage		2.7		3.6	V

Note 1: Guaranteed by design. Not tested in production.

Note 2: All Brownout Detectors use the Vref pin reference to generate the trig thresholds, so the Vref tolerances are to be added to the threshold detector tolerance.

Note 3:  $V_{refDC}$  is verified in production by measurement on Vrefbuf output.

# LEON3FT Microcontroller

## 57.12 Core Supply LDO Electrical Characteristics

Table 739. Characteristics for Core Supply LDO

Symbol	Parameter	Condition	Rating			Units
			Min.	Typ.	Max.	
$V_{OUT}^{2)}$	LDO output voltage, internally connected to $V_{DD\_CORE}$	$I_{OUT} = 0$ Settings in ca 25mV steps.				$V_{DC}$
		011 *		1.92		
		010		1.90		
		001		1.87		
		000		1.85		
		111		1.83		
		110		1.80		
		101		1.78		
		100		1.75		
		* Default setting after Reset, and recommended for $f_{intsys}=100$ MHz				
		Tolerance at room temperature:	-3 <sup>1)</sup>		3 <sup>1)</sup>	%
		Temperature drift:	-1 <sup>1)</sup>		1 <sup>1)</sup>	
$\Delta V_{OUT,Load}$	Load regulation	$I_{OUT} = 700$ mA <sub>DC</sub>	-0.14	-0.07		$V_{DC}$
$I_{OUT}$	LDO output current	Sum of supply currents internally to $V_{DD\_CORE}$ and externally to loads connected between $V_{DD\_CORE}$ and GND on PCB.	0 <sup>3)</sup>		700 <sup>3)</sup>	mA <sub>DC</sub>
$I_{DD\_LDO}$	Current consumption	$I_{OUT} = 0$		2		mA
$V_{DD\_LDO}^{4)}$	Supply voltage		3.0		3.6	V

Note 1: Tested in production for setting 011b (1.92 V) and 100b (1.75 V). Accuracy for the other settings is guaranteed by design, and these levels are functionally tested to provide stepwise decreasing voltage from 1.92 V down to 1.75 V.

Note 2: The LDO regulates  $V_{OUT}$  based on the  $V_{ref}$  pin reference.

Note 3: To maintain device long-term reliability,  $I_{OUT}$  of maximum 700 mA in average and maximum 1.1 A<sub>peak</sub> in repetitive pulse transients of maximum length in order of 100  $\mu$ s must be fulfilled. To guarantee full regulation performance of the output voltage,  $V_{OUT}$ , maximum 700 mA should be fulfilled. The LDO can supply external 1.8 V loads connected between  $V_{DD\_CORE}$  and GND on PCB, but these loads must not cause any violations of the above  $I_{OUT}$  limits, and must never back-feed any current into the LDO to maintain output voltage regulation and device long-term reliability.

Note 4: When the LDO is not used,  $V_{DD\_LDO}$  should be connected to  $V_{DD\_CORE}$ , and external supply is connected to  $V_{DD\_CORE}$ .



# LEON3FT Microcontroller

## 57.13 AC characteristics

Timing figures provided in this section are guaranteed by functional testing or measurements, unless otherwise noted.

All measured AC parameters are tested with capacitive load with at least 25 pF on the outputs. Timing measurements will be performed using a voltage level equivalent to  $V_{DD\_IO}/2$ . AC characteristics presented in this chapter is applicable within recommended operating conditions, see section 57.2

### 57.13.1 System clock timing

The timing waveforms are shown in figure 140, and the timing parameters are defined in table 740.

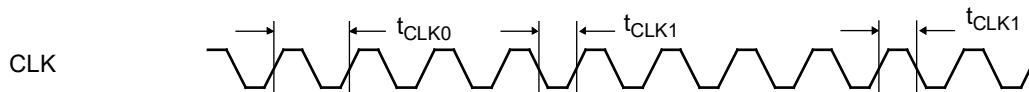


Figure 140. System clock timing waveforms

Table 740. System clock timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>CLK0</sub>	Clock period	-	10	1)	ns
t <sub>CLK1</sub>	Clock high/low pulse length	-	0.40 x t <sub>CLK0</sub>	0.60 x t <sub>CLK0</sub>	ns
t <sub>CLK2</sub>	Clock cycle jitter <sup>2)</sup>	-	-	1	ns

Note 1: Max value can not be larger than 8 x clock period of internal SpaceWire clock when SpaceWire is used.

Note 2: This is guaranteed by design.

### 57.13.2 External SpaceWire clock timing

The timing waveforms are shown in figure 141, and the timing parameters are defined in table 741.

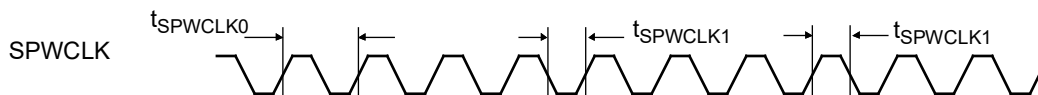


Figure 141. External SpaceWire clock timing waveforms

Table 741. External SpaceWire clock timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>SPWCLK0</sub>	Clock period <sup>1)</sup>	-	5 <sup>4)</sup>	-	ns
	Clock period <sup>2) 3)</sup>	-	10	200	ns
t <sub>SPWCLK1</sub>	Clock high/low pulse length <sup>1) 5)</sup>	-	0.45 x t <sub>SPWCLK0</sub>	0.55 x t <sub>SPWCLK0</sub>	ns
	Clock high/low pulse length <sup>2) 5)</sup>	-	0.40 x t <sub>SPWCLK0</sub>	0.60 x t <sub>SPWCLK0</sub>	ns
t <sub>SPWCLK2</sub>	Clock cycle jitter <sup>1) 5)</sup>	-	-100	100	ps
	Clock cycle jitter <sup>2) 5)</sup>	-	-	1	ns

Note 1: Only applicable when PLL is bypassed (see section 4).

Note 2: Only applicable when PLL use SPWCLK to generate internal SpaceWire clock (see chapter 4).

Note 3: If internal SpaceWire clock come from PLL then it cannot be set higher than 100 MHz.

# LEON3FT Microcontroller

Table 741. External SpaceWire clock timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
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Note 4: Min values given here is from static timing analysis, in production test lowest value used is 10 ns TBC.

Note 5: This is guaranteed by design.

## 57.13.3 External 1553B clock timing

The timing waveforms are shown in figure 142, and the timing parameters are defined in table 742.

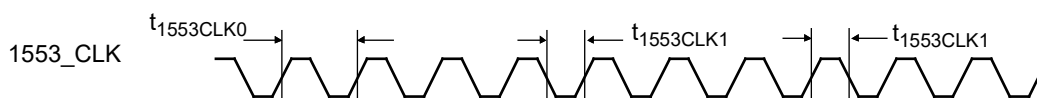


Figure 142. External 1553B clock timing waveforms

Table 742. External 1553B clock timing parameters

Name	Parameter	Reference edge	Typ	Unit
$t_{1553CLK0}$	Clock period	-	50	ns
$t_{1553CLK1}$	Clock high/low pulse length	-	25	ns

Note 1: External MIL-1553B clock is only available via IO mux, see chapter 2.5.

Note 2: Max value of  $t_{CLK0}$  cannot be larger than 2 x clock period of internal 1553B clock when 1553B is used.

## 57.13.4 External PacketWire Clock

The timing waveforms are shown in figure 143, and the timing parameters are defined in table 743.

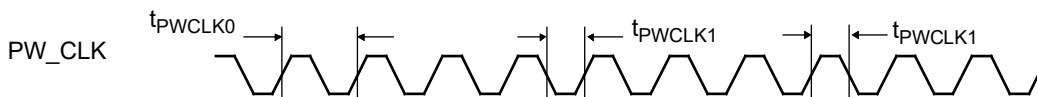


Figure 143. External PacketWire clock timing waveforms

Table 743. External PacketWire clock timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{PWCLK0}$	Clock period	-	100		ns
$t_{PWCLK1}^{2)}$	Clock high/low pulse length	-	0.40 x $t_{PWCLK0}$	0.60 x $t_{PWCLK0}$	ns
$t_{PWCLK2}^{2)}$	Clock cycle jitter	-	-100	100	ps

Note 1: External PacketWire clock is only available via IO mux, see chapter 2.5.

Note 2: This is guaranteed by design.

# LEON3FT Microcontroller

## 57.13.5 External SPI4S clock

The timing waveforms are shown in figure 144, and the timing parameters are defined in table 744.

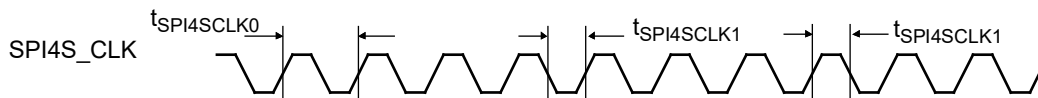


Figure 144. External SPI4S clock timing waveforms

Table 744. External PacketWire clock timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{SPI4SCLK0}$	Clock period	-	40 <sup>3)</sup>		ns
$t_{SPI4SCLK1}^{2)}$	Clock high/low pulse length	-	0.40 x $t_{SPI4SCLK0}$	0.60 x $t_{SPI4SCLK0}$	ns
$t_{SPI4SCLK2}^{2)}$	Clock cycle jitter	-	-100	100	ps

Note 1: External SPI4S clock is only available via IO mux, see chapter 2.5.

Note 2: This is guaranteed by design.

Note 3: Min values given here is from static timing analysis, in production test lowest value used is TBC ns.

## 57.13.6 Reset timing

The timing waveforms are shown in figure 145, and the timing parameters are defined in table 745. See chapter 8 for further information on RESET\_IN\_N and RESET\_OUT\_N.

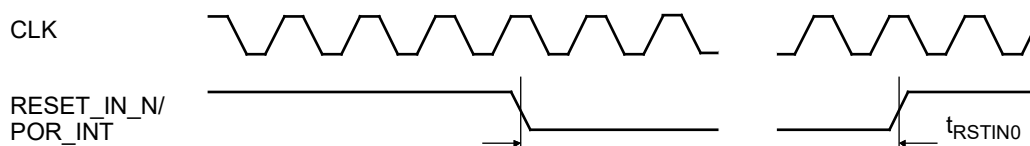


Figure 145. Reset timing waveforms

Table 745. Reset timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{RSTIN0}$	Asserted period	-	10 x $t_{CLK0}^{2) 3)}$	-	ns

Note 1: The RESET\_IN\_N input is re-synchronized internally, and does not have to meet any setup or hold requirements.

Note 2:  $V_{DD\_CORE}$  must reach at least minimum operating voltage before start for  $t_{RSTIN0}$  before RESET\_IN\_N is de-asserted.

Note 3: The internal reset for the system clock domain is released 30 x  $t_{CLK0}$  after RESET\_IN\_N is de-asserted. The internal reset for the SpaceWire clock domain is released 5 internal SpaceWire clock cycles after internal reset is de-asserted and PLL has acquired lock.

Note 4: POR\_INT is an internal signal from the on-chip POR circuit.

Note 5: This parameter is functional tested, and min time is guaranteed by design.

# LEON3FT Microcontroller

## 57.13.7 SPI Master and Memory interface timing

The timing waveforms are shown in figure 146, and the timing parameters are defined in table 746.

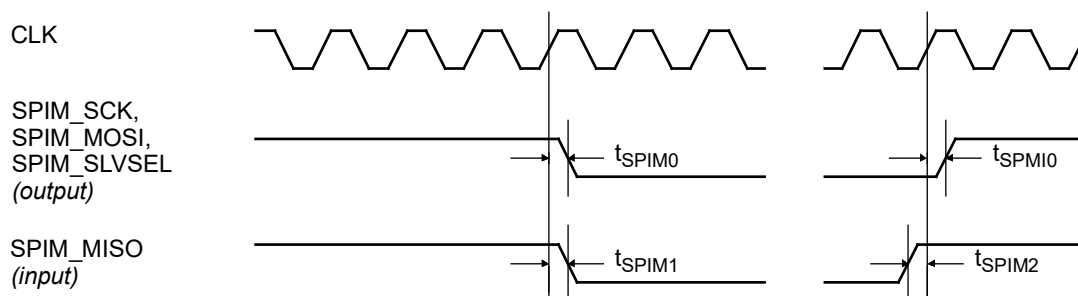


Figure 146. SPI interface timing waveforms

Table 746. SPI interface timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{SPIM0}^{2)}$	Clock to output delay	Rising CLK edge	0	45	ns
$t_{SPIM1}^{2)}$	Input to clock hold	Rising CLK edge	-	4	ns
$t_{SPIM2}^{2)}$	Input to clock setup	Rising CLK edge	-	4	ns

Note 1: The SPI\_MISO input is re-synchronized internally, and does not have to meet any setup or hold requirements.

Note 2: Verified by static timing analysis, not tested in production.

## 57.13.8 SPI Slave interface timing

The timing waveforms are shown in figure 147, and the timing parameters are defined in table 747.

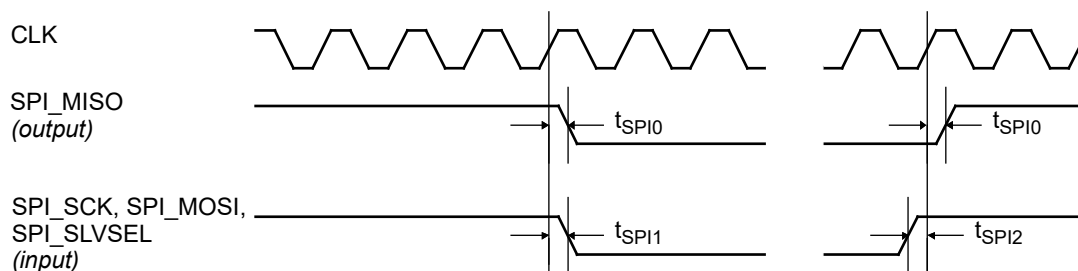


Figure 147. SPI interface timing waveforms

Table 747. SPI interface timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{SPI0}^{2)}$	Clock to output delay	Rising CLK edge	0	45	ns
$t_{SPI1}^{2)}$	Input to clock hold	Rising CLK edge	-	4	ns
$t_{SPI2}^{2)}$	Input to clock setup	Rising CLK edge	-	4	ns

Note 1: The SPI\_SCK, SPI\_MOSI and SPI\_SLVSEL inputs are re-synchronized internally, and does not have to meet any setup or hold requirements.

Note 2: Verified by static timing analysis, not tested in production.

# LEON3FT Microcontroller

## 57.13.9 SPI4S Slave interface CMOS timing

The timing waveforms are shown in figure 146, and the timing parameters are defined in table 748.

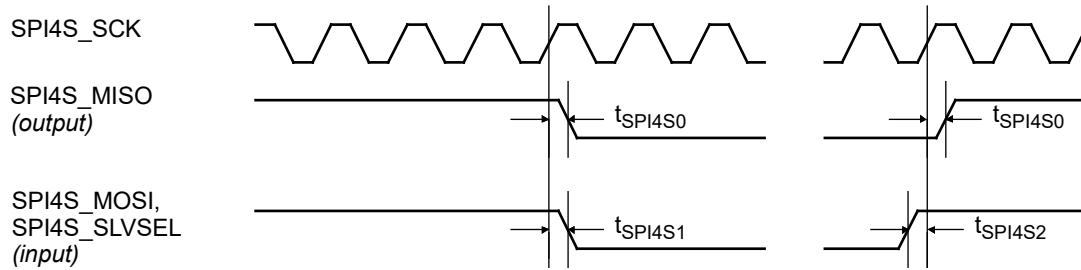


Figure 148. SPI interface timing waveforms

Table 748.SPI interface timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>SPI4S0</sub>	Clock to output delay	Rising SPI4S_CLK edge	0	45	ns
t <sub>SPI4S1</sub> <sup>1)</sup>	Input to clock hold	Rising SPI4S_CLK edge	-	4	ns
t <sub>SPI4S2</sub> <sup>1)</sup>	Input to clock setup	Rising SPI4S_CLK edge	-	4	ns

Note 1: Verified by static timing analysis, not tested in production.

## 57.13.10 SPI4S Slave interface LVDS timing

The timing waveforms are shown in figure 146, and the timing parameters are defined in table 749.

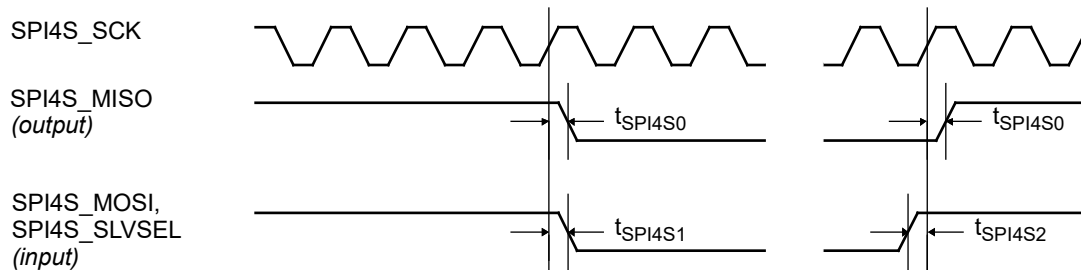


Figure 149. SPI interface timing waveforms

Table 749.SPI interface timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>SPI4S0_LVDS</sub>	Clock to output delay	Rising SPI4S_CLK edge	0	30	ns
t <sub>SPI4S1_LVDS</sub> <sup>1)</sup>	Input to clock hold	Rising SPI4S_CLK edge	-	4	ns
t <sub>SPI4S2_LVDS</sub> <sup>1)</sup>	Input to clock setup	Rising SPI4S_CLK edge	-	4	ns

Note 1: Verified by static timing analysis, not tested in production.

# LEON3FT Microcontroller

## 57.13.11 SpaceWire LVDS interface timing

The timing waveforms are shown in figure 150, and the timing parameters are defined in table 750.

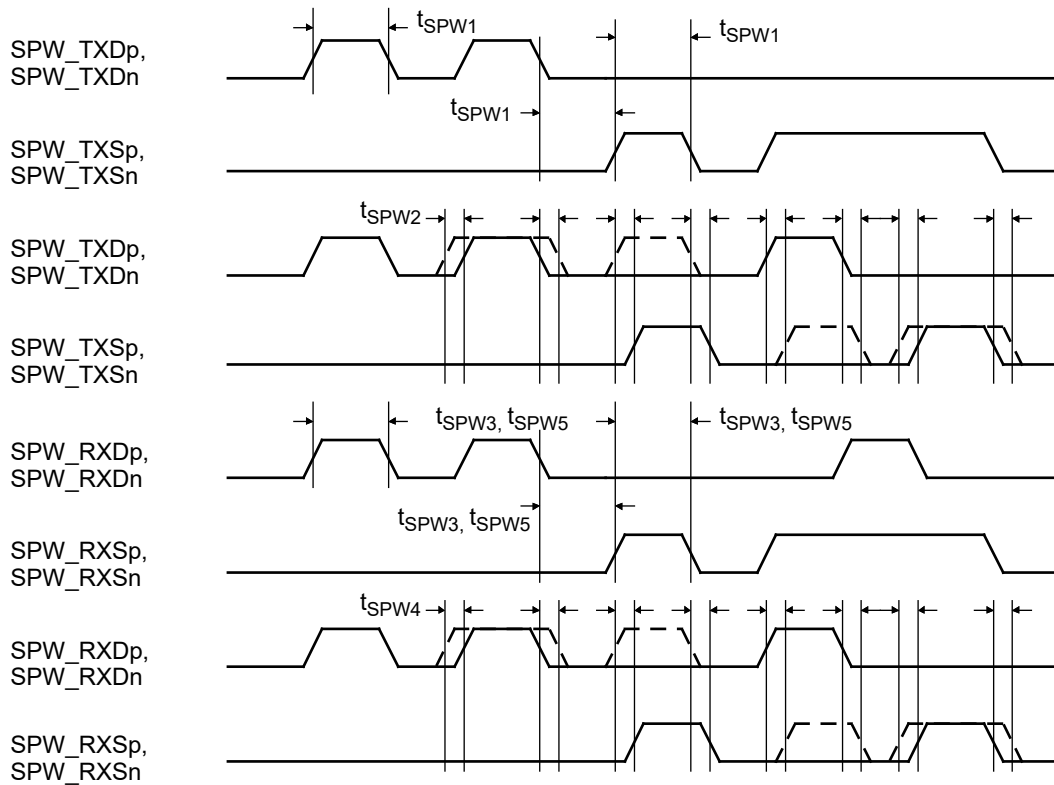


Figure 150. SpaceWire LVDS interface timing waveforms

Table 750. SpaceWire LVDS interface timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>SPW1_LVDS</sub>	Output data bit period	-	5 <sup>2)</sup>	500 <sup>1)</sup>	ns
t <sub>SPW2_LVDS</sub> <sup>1)</sup>	Data & strobe output skew & jitter	-	0	1.2	ns
t <sub>SPW3_LVDS</sub> <sup>1)</sup>	Input data bit period	-	5	500	ns
t <sub>SPW4_LVDS</sub> <sup>1)</sup>	Data & strobe input skew, jitter & hold	-	-	TBD	ns
t <sub>SPW5_LVDS</sub> <sup>1)</sup>	Data & strobe edge separation	-	2.5	-	ns

Note 1: Verified by static timing analysis, not tested in production.

Note 2: Min values given here is from static timing analysis, in production test lowest value used is TBC ns.

# LEON3FT Microcontroller

## 57.13.12 CANFD interface timing

The timing waveforms and timing parameters are shown in figure 151 and are defined in table 751.

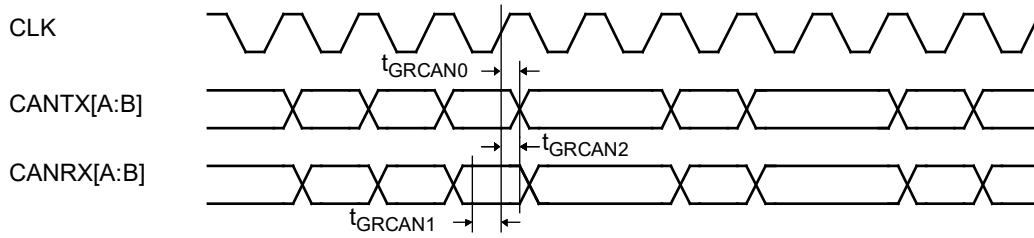


Figure 151. CANFD timing waveforms

Table 751. CANFD timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>GRCAN0</sub>	clock to data output delay	rising <i>clk</i> edge	0	45	ns
t <sub>GRCAN1</sub> <sup>1)</sup>	data input to clock setup	rising <i>clk</i> edge	-	4	ns
t <sub>GRCAN2</sub> <sup>1)</sup>	data input from clock hold	rising <i>clk</i> edge	-	4	ns

Note 1: Verified by static timing analysis, not tested in production.

Note 2: The CAN inputs are re-synchronized to the internal system clock with a t<sub>CLK0</sub> period. The signals do not have to meet any setup or hold requirements.

## 57.13.13 MIL-1553B interface timing

The timing waveforms and timing parameters are shown in figure 152 and are defined in table 752.

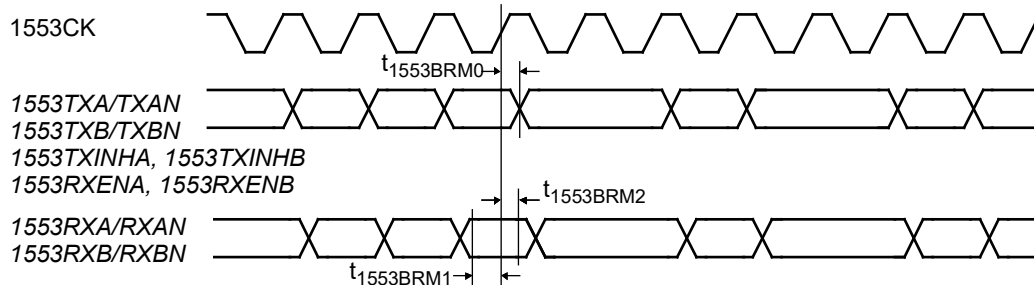


Figure 152. MIL-1553 timing waveforms

Table 752. MIL-1553 timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>1553BRM0</sub>	clock to data output delay	rising 1553CK edge	0	45	ns
t <sub>1553BRM1</sub> <sup>1)</sup>	data input to clock setup	rising 1553CK edge	-	4	ns
t <sub>1553BRM2</sub> <sup>1)</sup>	data input from clock hold	rising 1553CK edge	-	4	ns
t <sub>1553BRM3</sub>	clock frequency	1553CK	20 <sup>3)</sup>		MHz

Note 1: Verified by static timing analysis, not tested in production.

Note 2: The 1553RXA, 1553RXAN, 1553RXB and 1553RXBN inputs are re-synchronized internally to 1553CK. The signals do not have to meet any setup or hold requirements.

Note 3: The GR1553CK clock domains are production tested at typical frequency of 20 MHz using a clock generated on external pins. For correct AC requirement on the MIL-1553B interface clock see MIL-STD-1553B / AS15531 standard document.

**57.13.14 I2C-master**

The timing waveforms and timing parameters are shown in figure 153 and are defined in table 753.

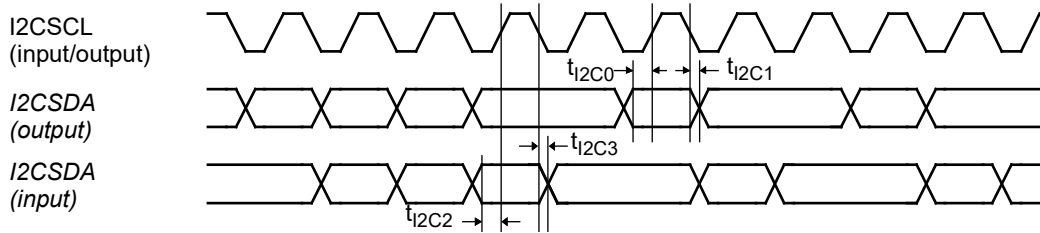


Figure 153. I2C-master timing waveforms

Table 753. I2C-master timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>I2C0</sub>	data output valid before clock	rising I2CSCL edge	-	scaler <sup>1)</sup>	t <sub>CLK0</sub> periods
t <sub>I2C1</sub>	data output valid after clock	falling I2CSCL edge	scaler <sup>1)</sup>	-	t <sub>CLK0</sub> periods
t <sub>I2C2</sub> <sup>5)</sup>	data input setup to clock	rising I2CSCL edge	2 <sup>2)</sup>	-	t <sub>CLK0</sub> periods
t <sub>I2C3</sub> <sup>5)</sup>	data input hold from clock	falling I2CSCL edge	0 <sup>2)</sup>	-	t <sub>CLK0</sub> periods

Note 1: The core's I2C bus functional timing depends on the IP-core's scaler value and the internal system clock t<sub>CLK0</sub> period. When the scaler is set for the IP-core to operate in Fast- or Standard-Mode, the timing characteristics in the I2C-bus specification apply. The maximum t<sub>CLK0</sub> period for proper operation is 50 ns.

Note 2: The I2CSCL and I2CSDA inputs are re-synchronized to the internal system clock with a t<sub>CLK0</sub> period.

Note 3: I2CSCL and I2CSDA are open-drain outputs, driving a logical 0 level or tri-state.

Note 4: For correct operation, the signals should be pulled-up externally with 10 kΩ.

Note 5: Verified by static timing analysis, not tested in production.

**57.13.15 PacketWire RX interface timing**

The timing waveforms and timing parameters are shown in figure 154 and are defined in table 754.

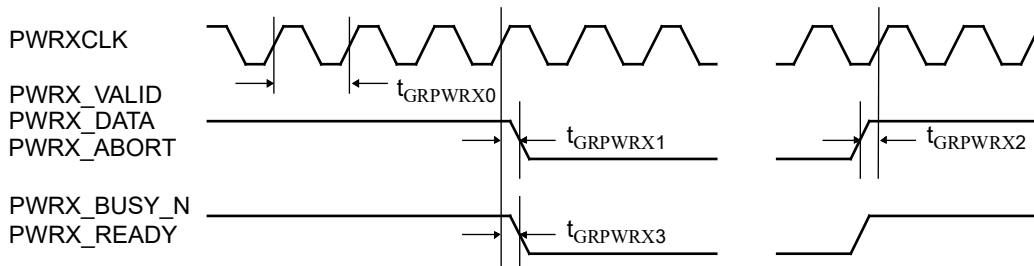


Figure 154. PacketWire Rx timing waveforms

Table 754. PacketWire Rx timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>GRPWRX0</sub>	bit period	rising PWRXCLK edge	100	-	ns
t <sub>GRPWRX1</sub> <sup>1)</sup>	data/active/abort input to clock hold	rising PWRXCLK edge	5	-	ns
t <sub>GRPWRX2</sub> <sup>1)</sup>	data/active/abort input to clock setup	rising PWRXCLK edge	5	-	ns
t <sub>GRPWRX3</sub> <sup>1)</sup>	clock to output delay	rising PWRXCLK edge		45	ns

Note 1: Verified by static timing analysis, not tested in production.



# LEON3FT Microcontroller

## 57.13.16 PacketWire TX interface timing

The timing waveforms and timing parameters are shown in figure 155 and are defined in table 755.

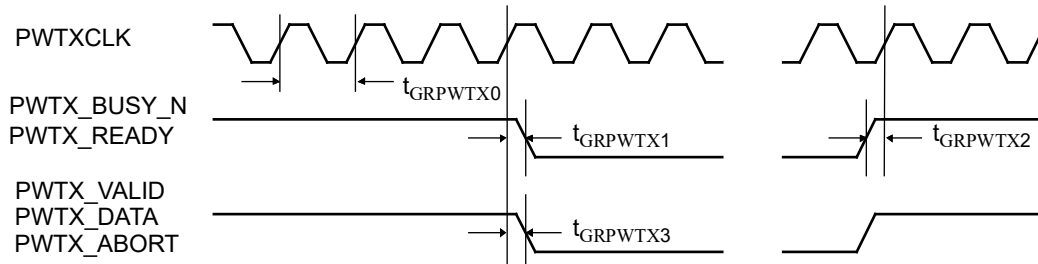


Figure 155. PacketWire TX timing waveforms

Table 755. PacketWire TX timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{GRPWTX0}$	bit period	rising SYS_CLK edge	100	-	ns
$t_{GRPWTX1}^{1)}$	data/active/abort input to clock hold	rising SYS_CLK edge	5	-	ns
$t_{GRPWTX2}^{1)}$	data/active/abort input to clock setup	rising SYS_CLK edge	5	-	ns
$t_{GRPWTX3}^{1)}$	clock to output delay	rising SYS_CLK edge	-	45	ns

Note 1: Verified by static timing analysis, not tested in production.

# LEON3FT Microcontroller

## 57.13.17 Fault-tolerant 8-bit PROM/IO memory interface timing

The timing waveforms and timing parameters are shown in figures 156, and are defined in table 756.

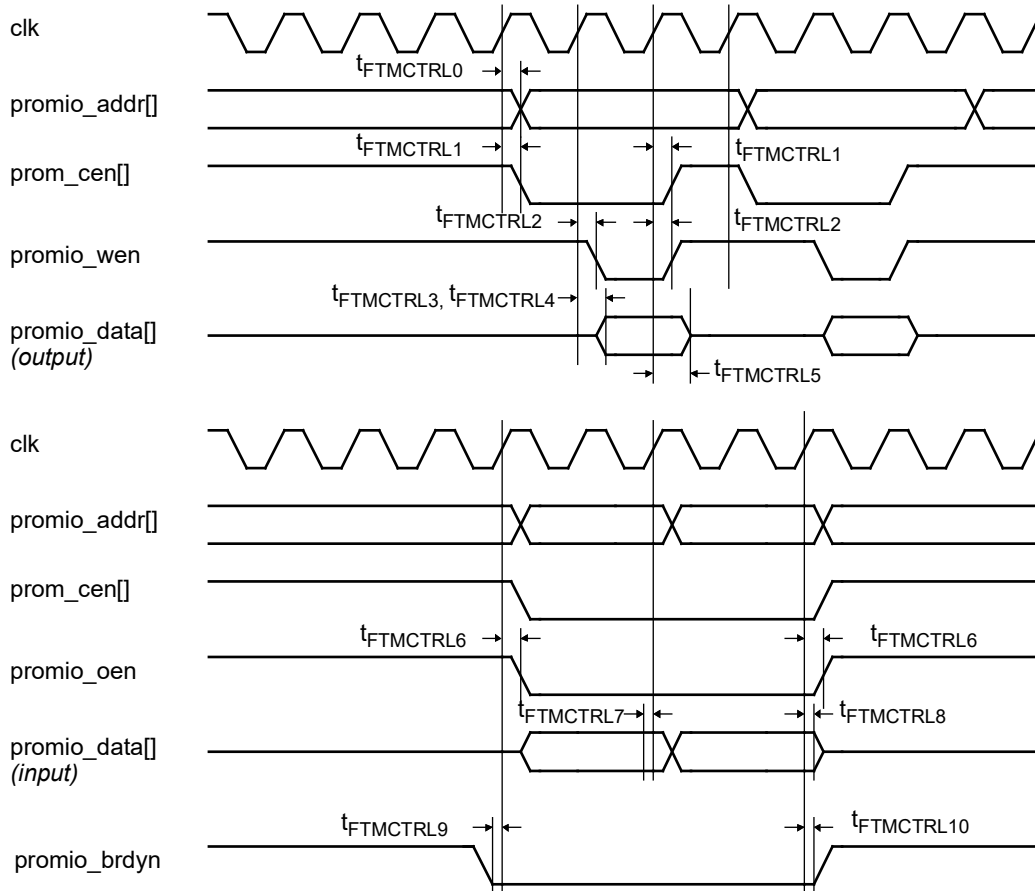


Figure 156. Timing waveforms - SRAM and PROM accesses

Table 756. PROM and I/O accesses timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
t <sub>FTMCTRL0</sub>	address clock to output delay	rising clk edge	0	45	ns
t <sub>FTMCTRL1</sub>	clock to output delay	rising clk edge	0	45	ns
t <sub>FTMCTRL2</sub>	clock to output delay	rising clk edge	0	45	ns
t <sub>FTMCTRL3</sub>	clock to data output delay	rising clk edge	0	45	ns
t <sub>FTMCTRL4</sub>	clock to data non-tri-state delay	rising clk edge	0	45 <sup>3)</sup>	ns
t <sub>FTMCTRL5</sub>	clock to data tri-state delay	rising clk edge	5 <sup>3)</sup>	45 <sup>3)</sup>	ns
t <sub>FTMCTRL6</sub>	clock to output delay	rising clk edge	0	45 <sup>3)</sup>	ns
t <sub>FTMCTRL7</sub>	data input to clock setup	rising clk edge	5 <sup>3)</sup>	-	ns
t <sub>FTMCTRL8</sub>	data input from clock hold	rising clk edge	-	-	ns
t <sub>FTMCTRL9</sub>	input to clock setup	rising clk edge	5 <sup>3)</sup>	-	ns
t <sub>FTMCTRL10</sub>	input from clock hold	rising clk edge	-	-	ns

Note 1: n/a

Note 2: n/a

Note 3: Verified by static timing analysis, not tested in production.

# LEON3FT Microcontroller

## 57.13.18 UART interface timing

The timing waveforms and timing parameters are shown in figure 157 and are defined in table 757.

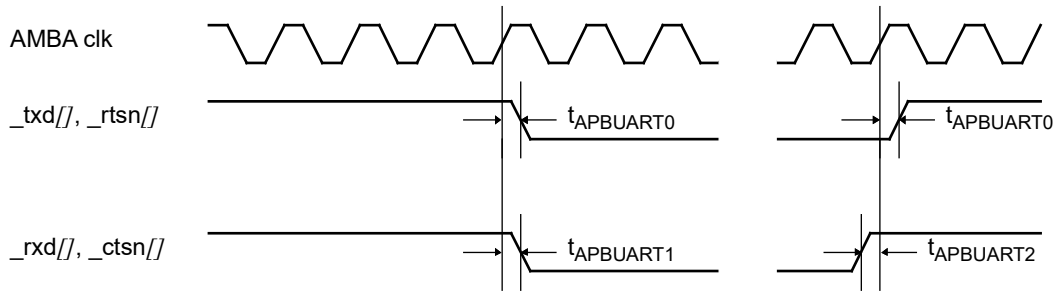


Figure 157. UART Timing waveforms

Table 757. UART timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{APBUART0}$	clock to output delay	rising clk edge	0	45	ns
$t_{APBUART1}$	input to clock hold	rising clk edge <sup>2)</sup>	-	4 <sup>2)</sup>	ns
$t_{APBUART2}$	input to clock setup	rising clk edge <sup>2)</sup>	-	4 <sup>2)</sup>	ns

Note 1: NA

Note 2: The `_ctsn` and `_rxn` inputs are re-synchronized internally. These signals do not have to meet any setup or hold requirements.

## 57.13.19 DSU signals timing

The timing waveforms and timing parameters are shown in figure 158 and are defined in table 758.

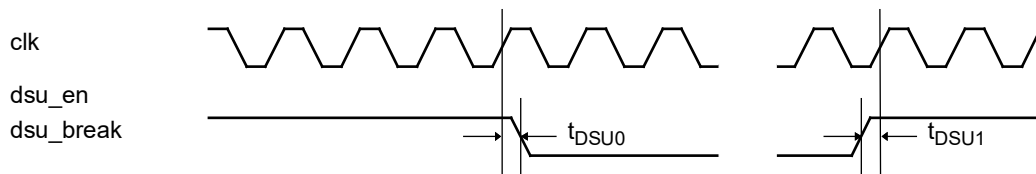


Figure 158. DSU timing waveforms

Table 758. DSU Timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{DSU0}$	input to clock hold	rising clk edge	- 1)	- 1)	ns
$t_{DSU1}$	input to clock setup	rising clk edge	- 1)	- 1)	ns

Note 1: The `dsu_break` and `dsu_en` signals are re-synchronized internally. These signals do not have to meet any setup or hold requirements. As the `dsu_en` signal controls clock gating for the Debug AHB bus the signal's value should be kept constant from power-up.

# LEON3FT Microcontroller

## 57.13.20 General purpose I/O timing

The timing waveforms are shown in figure 159, and the timing parameters are defined in table 759.

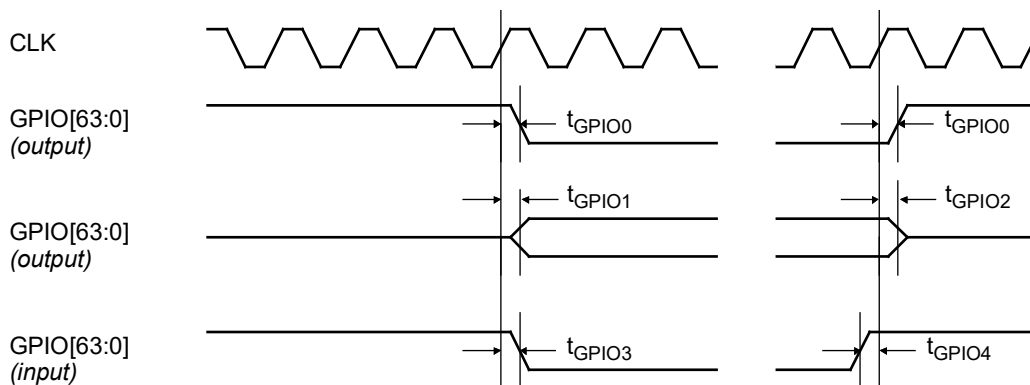


Figure 159. General purpose I/O timing waveforms

Table 759. General purpose I/O timing parameters

Name	Parameter	Reference edge	Min	Max	Unit
$t_{GPIO0}$	Clock to output delay	Rising CLK edge	0	45	ns
$t_{GPIO1}$	Clock to non-tri-state delay	Rising CLK edge	0	45	ns
$t_{GPIO2}$	Clock to tri-state delay	Rising CLK edge	0	45	ns
$t_{GPIO3}$	Input to clock hold	Rising CLK edge <sup>1)</sup>	-	-	ns
$t_{GPIO4}$	Input to clock setup	Rising CLK edge <sup>1)</sup>	-	-	ns

Note 1: The GPIO[...] inputs are re-synchronized to the internal system clock

Note 2: NA

# LEON3FT Microcontroller

## 58 Mechanical description

### 58.1 Component and package

The GR716 microcontroller is provided in a 132-lead CQFP package.

### 58.2 Pin assignment

The pin assignment in table 760 shows the implementation characteristics of each signal indicating how each pin has been configured in terms of electrical levels, drive capability and internal pull-up or pull-down.

Power supply and ground for all I/O pins are  $V_{DD\_IO}$  and GND, unless otherwise noted.

Table 760. Pin assignment

Name	I/O	Pin	Level	Drive [mA]	Pull <sup>2)</sup>	Active	Unused <sup>16)</sup>	Note
TESTEN	in	128	15)		Down	High	GND	Test mode enable. Pin shall always be connected to ground.
RESET_OUT_N	out	16	6)	2 <sup>6)</sup>	Down <sup>6)</sup>	Low	Open	Buffered copy of the internal system reset.
RESET_IN_N	in <sup>1)</sup>	17	14)		14)	Low	Pull to $V_{DD\_CORE}$	Generates internal system reset, and activates RESET_OUT_N. 3.6V tolerant without ESD diode to any positive supply. <b>Supply:</b> $V_{DD\_CORE}$ vs GND
C_RST <sup>3)</sup>	-	18	-			-	17)	Power-on reset timing. Connect to external capacitor.
VREFBUF	out	30	1.9V			-	Pull to GND	Analog precision reference voltage. For electrical characteristics see 57.10. <b>Supply:</b> $V_{DDA\_REF}$ vs $V_{SSA\_REF}$
VREF <sup>4)</sup>	-	31	-			-	17)	Bandgap reference. Connect to external capacitor.
RREF <sup>5)</sup>	-	32	-			-	17)	Bandgap reference. Connect to external resistor.
XO_OUT	out	58	CMOS	4		High	Open	Clock from crystal oscillator. Positive edge is performance characterized.
XO_X2	-	59	-			-	Pull to GND	Crystal oscillator. Connect to external crystal.
XO_X1	-	60	-			-	Pull to GND	Crystal oscillator. Connect to external crystal.
CLK	in <sup>1)</sup>	57	CMOS		Down	High	17)	System clock. It must always be applied.
SPWCLK	in <sup>1)</sup>	54	CMOS		Down	High	Pull to GND	SpaceWire and PLL clock
DSU_EN	in	5	CMOS		Down	High	Pull to GND	DSU enable
DSU_BREAK	in	6	CMOS		Down	High	Pull to GND	DSU break
DUART_RX	in <sup>1)</sup>	7	CMOS		Down	High	Pull to GND	Debug UART data receive
DUART_TX	inout	8	CMOS	4		High	Bootstrap <sup>18)</sup>	Debug UART data transmit
SPIM_SEL	inout	9	CMOS	2		Low	Bootstrap <sup>18)</sup>	SPI Memory select
SPIM_SCK	inout	10	CMOS	2		High	Bootstrap <sup>18)</sup>	SPI Memory data clock
SPIM_MOSI	inout	11	CMOS	2		High	Bootstrap <sup>18)</sup>	SPI Memory master out / slave in
SPIM_MISO	in <sup>1)</sup>	12	CMOS		Up	High	Pull to $V_{DD\_IO}$	SPI Memory master in / slave out

# LEON3FT Microcontroller

Table 760. Pin assignment

Name	I/O	Pin	Level	Drive [mA]	Pull 2)	Active	Unused 16)	Note
LVDS_TX[0]p	out	42	LVDS			High	Pull to GND 20)	LVDS transmitters, with <b>cold-spare capability</b> . See section 2.5 for functionality. <b>Supply:</b> V <sub>DD_LVDS</sub> vs GND for pin 42-53
LVDS_TX[0]n	out	43	LVDS			Low	Pull to GND 20)	
LVDS_TX[1]p	out	44	LVDS			High	Pull to GND 20)	
LVDS_TX[1]n	out	45	LVDS			Low	Pull to GND 20)	
LVDS_TX[2]p / LVDS_RX[0]p	out / in	46	LVDS			High	Pull to GND 19) 20)	LVDS transmitter or receiver configurable, with <b>cold-spare capability</b> . See section 2.5 for functionality.
LVDS_TX[2]n / LVDS_RX[0]n	out / in	47	LVDS			Low	Pull to GND 19) 20)	
LVDS_RX[1]p	in	48	LVDS			High	Pull to GND 19)	LVDS receivers with <b>extended common mode and cold-spare capabilities</b> . See section 2.5 for functionality.
LVDS_RX[1]n	in	49	LVDS			Low	Pull to GND 19)	
LVDS_RX[2]p	in	50	LVDS			High	Pull to GND 19)	
LVDS_RX[2]n	in	51	LVDS			Low	Pull to GND 19)	
LVDS_RX[3]p	in	52	LVDS			High	Pull to GND 19)	
LVDS_RX[3]n	in	53	LVDS			Low	Pull to GND 19)	
GPIO[0]	inout	82	CMOS	2	8)	8)	Bootstrap 18)	Schmitt trigger input selectable
GPIO[1]	inout	83	CMOS	2	8)	8)	Bootstrap 18)	Schmitt trigger input selectable
GPIO[2]	inout	84	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[3]	inout	85	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[4]	inout	86	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[5]	inout	90	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[6]	inout	91	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[7]	inout	92	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[8]	inout	93	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[9]	inout	94	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[10]	inout	95	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[11]	inout	96	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[12]	inout	97	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[13]	inout	98	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[14]	inout	99	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[15]	inout	100	CMOS	2	8)	8)	Bootstrap 18)	Schmitt trigger input selectable
GPIO[16]	inout	104	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[17]	inout	105	CMOS	2	8)	8)	Bootstrap 18)	Schmitt trigger input selectable
GPIO[18]	inout	106	CMOS	2	8)	8)	Bootstrap 18)	Schmitt trigger input selectable
GPIO[19]	inout	107	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[20]	inout	108	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[21]	inout	109	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[22]	inout	110	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[23]	inout	111	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[24]	inout	112	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[25]	inout	113	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[26]	inout	114	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[27]	inout	118	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[28]	inout	119	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[29]	inout	120	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[30]	inout	121	CMOS	2	8)	8)	13)	Schmitt trigger input selectable

Table 760. Pin assignment

Name	I/O	Pin	Level	Drive [mA]	Pull <sup>2)</sup>	Active	Unused <sup>16)</sup>	Note
GPIO[31]	inout	122	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[32]	inout	123	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[33]	inout	124	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[34]	inout	125	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[35]	inout	126	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[36]	inout	127	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[37]	inout	21	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	General purpose IO with analog <b>ADC and ACOMP input capabilities</b> . See section 2.5 for functionality. <b>Supply:</b> V <sub>DDA_ADC</sub> vs V <sub>SSA_ADC</sub>
GPIO[38]	inout	22	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[39]	inout	23	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[40]	inout	24	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[41]	inout	25	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[42]	inout	26	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[43]	inout	27	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[44]	inout	28	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[45]	inout	34	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	General purpose IO with analog <b>DAC output and ACOMP input capabilities</b> . See section 2.5 for functionality. <b>Supply:</b> V <sub>DDA_DAC</sub> vs V <sub>SSA_DAC</sub>
GPIO[46]	inout	35	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[47]	inout	36	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[48]	inout	37	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[49]	inout	64	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[50]	inout	65	CMOS	2	8)	8)	13)	Schmitt trigger input selectable
GPIO[51]	inout	66	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	General purpose IO with analog <b>ADC and ACOMP input capabilities</b> . See section 2.5 for functionality. <b>Supply:</b> V <sub>DD_IO</sub> vs GND (pin 75 closest GND analog sense pin)
GPIO[52]	inout	67	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[53]	inout	68	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[54]	inout	69	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[55]	inout	70	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[56]	inout	71	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[57]	inout	72	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[58]	inout	73	CMOS <sup>7)</sup>	2 <sup>7)</sup>	8)	8)	13)	
GPIO[59]	inout	77	CMOS	2 <sup>7)</sup>	8)	8)	13)	General purpose IO with <b>LVDS TX capability</b> . See section 2.5 for functionality.
LVDS_TX[4]p	out		LVDS			High	20)	
GPIO[60]	inout	78	CMOS	2 <sup>7)</sup>	8)	8)	13)	
LVDS_TX[4]n	out		LVDS			High	20)	
GPIO[61]	inout	79	CMOS	2 <sup>7)</sup>	8)	8)	13)	
LVDS_TX[5]p	out		LVDS			High	20)	
GPIO[62]	inout	80	CMOS	2 <sup>7)</sup>	8)	8)	Bootstrap <sup>18) 20)</sup>	
LVDS_TX[5]n	out		LVDS			High		
GPIO[63]	inout	81	CMOS	2	8)	8)	Bootstrap <sup>18)</sup>	Schmitt trigger input selectable
VDD_CORE	-	1, 15, 61, 76, 89, 103, 117, 132					9)	Core 1.8V supply <sup>9) 10)</sup>
VDD_IO	-	4, 13, 63, 74, 87, 101, 115, 129					17)	I/O 3.3V supply <sup>10)</sup>

# LEON3FT Microcontroller

Table 760. Pin assignment

Name	I/O	Pin	Level	Drive [mA]	Pull <sup>2)</sup>	Active	Unused <sup>16)</sup>	Note
VDD_LVDS	-	40					17)	LVDS I/O 3.3V supply <sup>10)</sup>
VDD_LDO	-	2, 131					9)	LDO 3.3V supply <sup>9) 10)</sup>
GND	-	3, 14, 41, 62, 75, 88, 102, 116, 130					17)	Digital ground <sup>10)</sup>
VDDA_ADC	-	19					17)	ADC 3.3V analog supply <sup>10) 12)</sup>
VSSA_ADC	-	20					17)	ADC analog ground <sup>10) 12)</sup>
VDDA_REF	-	29					17)	REF 3.3V analog supply <sup>10) 12)</sup>
VSSA_REF	-	33					17)	REF analog ground <sup>10) 12)</sup>
VDDA_DAC	-	39					17)	DAC 3.3V analog supply <sup>10) 12)</sup>
VSSA_DAC	-	38					17)	DAC analog ground <sup>10) 12)</sup>
VDDA_PLL	-	55					17)	PLL 1.8V analog supply <sup>11)</sup>
VSSA_PLL	-	56					17)	PLL analog ground <sup>11)</sup>

Note 1: Schmitt trigger input.

Note 2: Internal pull up/down resistor is 30kΩ unless otherwise stated, which can be regarded a weak pull value but should be able to keep the internal chip signal at safe level in case of pin open-circuit failure, since no external PCB wire then is present to pick up disturbances. If a pin will be unused, it is recommended to connected a pull resistor on PCB with lower value to ensure safe level against disturbances.

Note 3: Connect only to ground via external capacitor. It is not recommended to leave the C<sub>RST</sub> pin unconnected, due to disturbance risk from other PCB circuitry, which could generate false reset. For functional capacitance values see section 57.11.

Note 4: Connect only to ground via 4.7nF decoupling capacitor.

Note 5: Connect only to ground via resistance of 5.11kΩ.

Note 6: RESET\_OUT\_N output drive capability is 2mA CMOS at high level and internal passive pull-down of 10kΩ at low level. It is valid also during power ramp up and down due to the passive pull-down resistor. External leakage or disturbance from PCB circuitry, pulling this node up, is recommended to not exceed 10uA to ensure a safe low level. Refer chapter 8 for more information regarding reset.

Note 7: Applies only for digital CMOS functionality.

Note 8: Parameter is programmable when digital functionality is selected for pin. Pull up/down resistor value is 50kΩ.

Note 9: In single supply mode, V<sub>DD\_LDO</sub> is recommended to be connected to same 3.3V supply as V<sub>DD\_IO</sub> (for simultaneous ramp up/down), and no external 1.8V supply shall be connected to V<sub>DD\_CORE</sub>. In single supply mode, the maximum decoupling capacitance on V<sub>DD\_CORE</sub> must not be more than 400 uF (well damped).

In dual supply mode, V<sub>DD\_LDO</sub> should be connected to V<sub>DD\_CORE</sub>, and external 1.8V supply connected to V<sub>DD\_CORE</sub>.

Note 10: External decoupling should be added in all supply modes and as close as possible to the supply pins. Typically add a 10nF ceramic capacitor per supply pin pair (e.g. X7R), and distributed across the PCB at least two 100uF well damped capacitors (or add 0.1Ω pulse-withstand rated resistor in series with each ceramic 100uF capacitor).

Note 11: The PLL supply pin pair, V<sub>DDA\_PLL</sub> and V<sub>SSA\_PLL</sub>, is supplied from internal LDO. External decoupling should be a ceramic capacitor of about 2uF (e.g. 2.2uF, X7R). The V<sub>DDA\_PLL</sub> pin must not be connected to anything else on PCB.

Note 12: It is recommended to use separate power supplies for analog supply or to insert local LP filters. For example, use one LP filter with 1Ω resistor (pulse-withstand rated) and 10uF (typically X7R) that supplies all three analog domains (V<sub>DDA\_ADC</sub>, V<sub>DDA\_DAC</sub> and V<sub>DDA\_REF</sub>). Also decouple each V<sub>DDA</sub> pin with 10nF (typically X7R). V<sub>SSA\_ADC</sub> and V<sub>SSA\_REF</sub> shall be connected to the same ground plane on PCB, to maintain full functionality and performance of ADC 0-2.

Note 13: Unused GPIO pin should have a pull-down of 10kΩ to ground, and it can then be configured to arbitrary mode (input, output, disable, etc). Alternatively, the pin can be left open but it should then be configured to digital output at all times.

Note 14: Internal pull resistor of 100kΩ to V<sub>DD\_CORE</sub>. See section 57.11 for further electrical characteristics. Refer to chapter 8 for more information regarding reset.



# LEON3FT Microcontroller

Table 760. Pin assignment

Name	I/O	Pin	Level	Drive [mA]	Pull <sup>2)</sup>	Active	Unused <sup>16)</sup>	Note
Note 15:								TESTEN input shall always be low-impedance grounded, also during supply voltage ramp up and down.
Note 16:								This column specifies termination for unused pins. The termination resistance is recommended to be 10kΩ unless otherwise noted. The pin state is assumed to be stable immediately after power-on or reset of the device.
Note 17:								Pin should always be connected according to table in 57.2.
Note 18:								Bootstrap pins should always be strapped to V <sub>DD_IO</sub> or GND via 10 kΩ, unless otherwise noted, depending on selected boot mode. See section 3.1 for more information.
Note 19:								When an LVDS receiver is enabled, it will not be damaged by inputs left unconnected, but it should not have fail-safe enabled. Random data to the core logic could be generated by disturbance if differential input voltage happens to be close to zero. To avoid these issues it is recommended that an unused or unconnected receiver is disabled, which also will save power consumption.
Note 20:								LVDS transmitters should be disabled when not used.

# LEON3FT Microcontroller

## 58.3 Mechanical package drawings

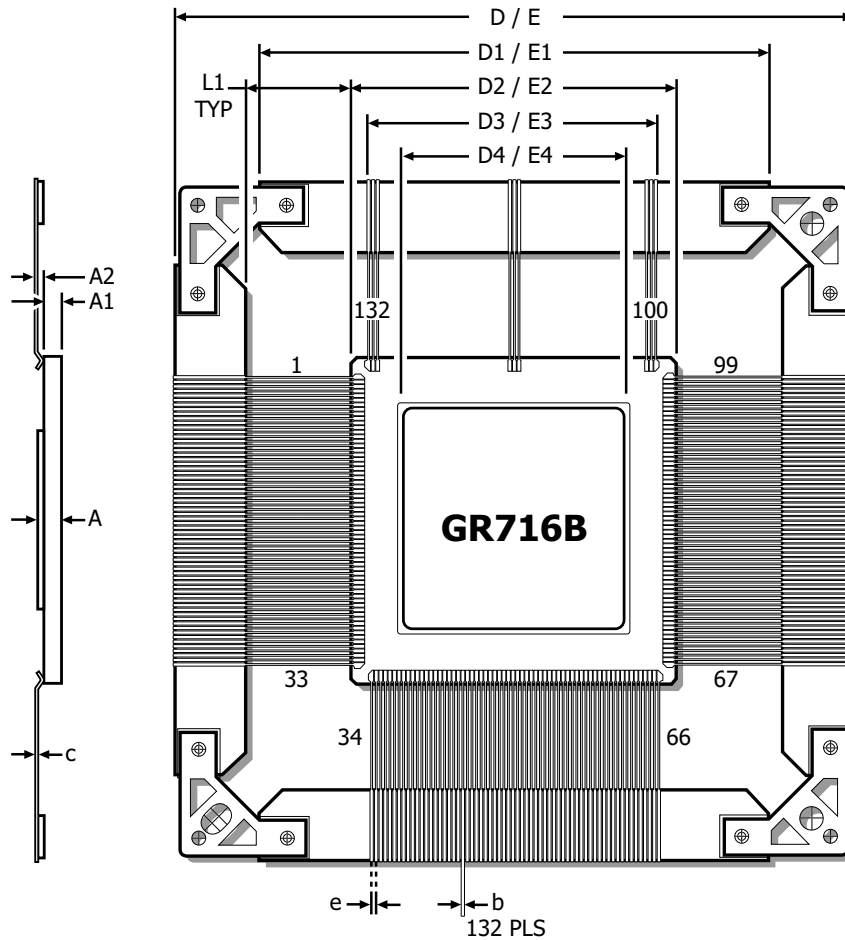


Figure 160. 132 CQFP package top view

Table 761. Package dimensions<sup>1) 2)</sup>

Name	Parameter	Min	TYP	Max	Unit
A			3.05	3.5	mm
A1		1.84		2.26	mm
A2		0.27		0.53	mm
b1	Width of lead when closest to case	0.23		0.329	mm
b2	Width of lead when closest to ceramic bar	0.15		0.25	mm
c		0.075		0.175	mm
D/E			50.85		mm
D1/E1			30.73		mm
D2/E2		25.10		25.48	mm
D3/E3			20.32		mm
D4/E4			22.0		mm
e			0.635		mm

# LEON3FT Microcontroller

Table 761. Package dimensions<sup>1) 2)</sup>

Name	Parameter	Min	TYP	Max	Unit
L1	Length of lead from case to ceramic bar (L2+L3)		7.75		mm
L2	Length of lead with width b1		6.45		mm
L3	Length of lead with width b2		1.3		mm

Note 1: The lid is internally connected to GND

Note 2: Mass of case, including the lead frames, shall be  $9 \pm 0.5$  grams including non-conductive tie-bar. After cut and form, the weight is estimated to 6.5 gram.

# LEON3FT Microcontroller

## 59 Ordering information

Please contact Frontgrade Gaisler AB through sales@gaisler.com. Ordering information is provided in table 762 and a legend is provided in table 763.

Table 762. Ordering information, available models and legacy models

Product	Description
GR716B-CP-CQ132 <sup>1)</sup>	Engineering model (Prototype)
GR716B-MP-CQ132 <sup>1)</sup>	Electrical Qualification Model
GR716B-MS-CQ132 <sup>1)</sup>	Fight model
GR716B-DD-CQ132 <sup>1) 2)</sup>	Dummy package model
GR716B-XX-CQ132 <sup>1)</sup>	First available engineering model (Prototype)

Note 1: Contact Frontgrade Gaisler AB through sales@gaisler.com for availability.

Note 2: Electrical rejects may be used in lieu of dummy package model

Table 763. Ordering legend

Designator	Option	Description
Product	GR716B	Radiation-Tolerant LEON3 Microcontroller.
Temperature Range	M	-55°C to +125°C (Military range)
	C	0°C to +70°C (Commercial range)
	X	Prototypes, tested at room temperature only
	D	Reserved for Dummy package
Screening level and assembly flow	S	Space grade
	P	Prototype grade
	X	First assembled prototypes
	D	Reserved for Dummy package
Package Type	CQ	Ceramic Quad Flat Pack (CQFP) <sup>1)</sup>
Lead Count	132	Number of leads

Note 1: Gold lead finish

# LEON3FT Microcontroller

## 59.1 Silicon and mask information

This section describes changes and updates for silicon and metal-mask versions.

For more information contact [support@gaisler.com](mailto:support@gaisler.com).

Table 764 lists silicon and mask change and errata corrected. Errata information is further described in section 60.1.

*Table 764.* Silicon and mask change description and list of errata corrected by update

Silicon <sup>1)</sup>	Mask <sup>2)</sup>	Errata Corrected	Description
-	-		

Note 1: Silicon is a set of masks of dozen or so (varies with process and manufacturer) individual masks that are required to complete a product wafer fabrication from start to finish.

Note 2: Mask defines the geometrical pattern to be used for a single step in the manufacturing process of the product wafer

# LEON3FT Microcontroller

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## 60 Errata

This chapter describes known issues with current existing silicon.

If not otherwise stated, the items in this section are planned for correction in the next revision of the silicon.

For more information contact [support@gaisler.com](mailto:support@gaisler.com).

### 60.1 Overview

Table 765 lists errata that are further described in section 60.2.

*Table 765. Errata*

ID	Device(s) Affected	Name / Description
-	-	-

### 60.2 Errata description

#### 60.2.1 TBD Name

**ID:** GR716B-ERRATA-TBD

TBD Description.

**Workaround:** N/A

This item is planned to be corrected for the next revision of the silicon -TBD.

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